REJ09B0006-0500H

Everywhere you imagine. RENESAS

The revision list can be viewed directly by clicking the title page.

The rivision list summarizes the locations of revisions and additions. Details should always be checked by referring to the relevant text.

16

H8/3069RF-ZTAT™

Hardware Manual

Renesas 16-Bit Single-Chip Microcomputer

H8/3069R HD64F3069R

Hardware Manual

Rev. 5.00
Revision date: Sep. 10, 2004

Renesas Technology
www.renesas.com

Keep safety first in your circuit designs!

1. Renesas Technology Corp. puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage.
   Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of nonflammable material or (iii) prevention against any malfunction or mishap.

Notes regarding these materials

1. These materials are intended as a reference to assist our customers in the selection of the Renesas Technology Corp. product best suited to the customer's application; they do not convey any license under any intellectual property rights, or any other rights, belonging to Renesas Technology Corp. or a third party.
2. Renesas Technology Corp. assumes no responsibility for any damage, or infringement of any third-party's rights, originating in the use of any product data, diagrams, charts, programs, algorithms, or circuit application examples contained in these materials.
3. All information contained in these materials, including product data, diagrams, charts, programs and algorithms represents information on products at the time of publication of these materials, and are subject to change by Renesas Technology Corp. without notice due to product improvements or other reasons. It is therefore recommended that customers contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor for the latest product information before purchasing a product listed herein.
   The information described here may contain technical inaccuracies or typographical errors.
   Renesas Technology Corp. assumes no responsibility for any damage, liability, or other loss rising from these inaccuracies or errors.
   Please also pay attention to information published by Renesas Technology Corp. by various means, including the Renesas Technology Corp. Semiconductor home page (http://www.renesas.com).
4. When using any or all of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to evaluate all information as a total system before making a final decision on the applicability of the information and products. Renesas Technology Corp. assumes no responsibility for any damage, liability or other loss resulting from the information contained herein.
5. Renesas Technology Corp. semiconductors are not designed or manufactured for use in a device or system that is used under circumstances in which human life is potentially at stake. Please contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor when considering the use of a product contained herein for any specific purposes, such as apparatus or systems for transportation, vehicular, medical, aerospace, nuclear, or undersea repeater use.
6. The prior written approval of Renesas Technology Corp. is necessary to reprint or reproduce in whole or in part these materials.
7. If these products or technologies are subject to the Japanese export control restrictions, they must be exported under a license from the Japanese government and cannot be imported into a country other than the approved destination.
   Any diversion or reexport contrary to the export control laws and regulations of Japan and/or the country of destination is prohibited.
8. Please contact Renesas Technology Corp. for further details on these materials or the products contained therein.

General Precautions on Handling of Product

1. Treatment of NC Pins

Note: Do not connect anything to the NC pins.
The NC (not connected) pins are either not connected to any of the internal circuitry or are they are used as test pins or to reduce noise. If something is connected to the NC pins, the operation of the LSI is not guaranteed.

2. Treatment of Unused Input Pins

Note: Fix all unused input pins to high or low level.
Generally, the input pins of CMOS products are high-impedance input pins. If unused pins are in their open states, intermediate levels are induced by noise in the vicinity, a pass-through current flows internally, and a malfunction may occur.

3. Processing before Initialization

Note: When power is first supplied, the product's state is undefined.
The states of internal circuits are undefined until full power is supplied throughout the chip and a low level is input on the reset pin. During the period where the states are undefined, the register settings and the output state of each pin are also undefined. Design your system so that it does not malfunction because of processing while it is in this undefined state. For those products which have a reset function, reset the LSI immediately after the power supply has been turned on.

4. Prohibition of Access to Undefined or Reserved Addresses

Note: Access to undefined or reserved addresses is prohibited.
The undefined or reserved addresses may be used to expand functions, or test registers may have been be allocated to these addresses. Do not access these registers; the system's operation is not guaranteed if they are accessed.

Preface

This LSI is a high-performance single-chip microcontrollers that integrates peripheral necessary for system configuration with an H8/300H CPU featuring a 32-bit internal architecture as its core.

The on-chip peripheral functions include ROM, RAM, 16-bit timers, 8-bit timers, a programmable timing pattern controller (TPC), a watchdog timer (WDT), a three-channel serial communication interface, a two-channel D/A converter, an A/D converter, and I/O ports, providing an ideal configuration as a microcomputer for embedding in sophisticated control systems. Flash memory (F-ZTAT™*) is available as on-chip ROM, enabling users to respond quickly and flexibly to changing application specifications and the demands of the transition from initial to full-fledged volume production.

Note: * F-ZTAT is a trademark of Renesas Technology Corp.

Intended Readership: This manual is intended for users undertaking the design of an application system using the H8/3069RF-ZTAT™. Readers using this manual require a basic knowledge of electrical circuits, logic circuits, and microcomputers.

Purpose: The purpose of this manual is to give users an understanding of the hardware functions and electrical characteristics of the H8/3069RF-ZTAT™. Details of execution instructions can be found in the H8/300H Series Programming Manual, which should be read in conjunction with the present manual.

Using this Manual:

- For an overall understanding of the H8/3069RF-ZTAT™'s functions
  Follow the Table of Contents. This manual is broadly divided into sections on the CPU, system control functions, peripheral functions, and electrical characteristics.

- For a detailed understanding of CPU functions
  Refer to the separate publication, H8/300H Series Programming Manual.
  In order to understand the details of a register when its name is known. The addresses, bits, and initial values of the registers are summarized in Appendix B, Internal I/O Registers.

Related Material: The latest information is available at our Web Site. Please make sure that you have the most up-to-date information available.
(http://www.renesas.com)

User's Manual on the H8/3069RF-ZTAT™:

Manual Title	Document No.
H8/3069RF-ZTAT™ Hardware Manual	This manual
H8/300H Series Programming Manual	ADE-602-053

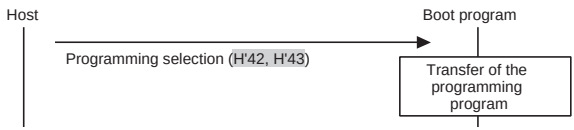
Usr's Manuals for development tools:

Manual Title	Document No.
H8S, H8/300 Series C/C++ Compiler, Assembler, Optimizing Linkage Editor User's Manual	ADE-702-247
H8S, H8/300 Series Simulator/Debugger User's Manual	ADE-702-037
High-Performance Embedded Workshop User's Manual	ADE-702-201
H8S, H8/300 Series High-Performance Embedded Workshop, High-Performance Debegging Interface Tutorial	ADE-702-231

Application Note:

Manual Title	Document No.
Microcomputer H8/300H Series Application Notes for CPU	ADE-502-033
H8/300H Series On-Chip Supporting Modules Application Note	ADE-502-035
Microcomputer Technical Q&A H8/300H Series Application Notes	ADE-502-038

Main Revisions for this Edition

Item	Page	Revisions (See Manual for Details)
5.1.1 Features	83	Description amended • Seven external interrupt pins …. For each of $\overline{IRQ_0}$ to $\overline{IRQ_5}$, sensing of the falling edge or level sensing can be selected independently.
5.1.2 Block Diagram Figure 5.1 Interrupt Controller Block Diagram	84	Figure 5.1 amended (Before) IRQ input → (After) $\overline{IRQ}$ input
5.2.4 IRQ Enable Register (IER)	95	Description amended (Before) IRQ_5 to IRQ_0 interrupts → (After) IRQ_5 to IRQ_0 interrupts request
18.10.1 Serial Communication Interface Specification for Boot Mode	650	(2) Device Selection Description amended — Size (1 byte) : Amount of device-code data This is fixed to 4
	655, 656	(11) New Bit-Rate Selection Description amended — Number of multiplication ratios (1 byte) : The number of multiplication ratios to which the device can be set. Normally the value is two: main operating frequency and peripheral module operating frequency. (With this LSI it should be set to H'01.) — Multiplication ratio 2 (1 byte): — Multiplication ratio (1 byte) : The value of the multiplication ratio (e.g. when the clock frequency is multiplied by four, the multiplication ratio will be H'04. Cannot be set for this LSI.)
Figure 18.27 Programming Sequence	661	• Programming Figure 18.27 amended 

Item	Page	Revisions (See Manual for Details)
18.10.1 Serial Communication Interface Specification for Boot Mode	662	(3) 128-byte programming Description amended — Programming Address (4 bytes) : Start address for programming Multiple of the size specified in response to the programming unit inquiry (i.e. H'00, H'01, H'00, H'00: H'00010000)
21.5 Usage Notes	771	Item added

Contents

Section 1 Overview 1
1.1 Overview 1
1.2 Block Diagram 6
1.3 Pin Description 7
1.3.1 Pin Arrangement 7
1.3.2 Pin Functions 8
1.3.3 Pin Assignments in Each Mode 13

Section 2 CPU 17
2.1 Overview 17
2.1.1 Features 17
2.1.2 Differences from H8/300 CPU 18
2.2 CPU Operating Modes 19
2.3 Address Space 20
2.4 Register Configuration 21
2.4.1 Overview 21
2.4.2 General Registers 22
2.4.3 Control Registers 23
2.4.4 Initial CPU Register Values 24
2.5 Data Formats 25
2.5.1 General Register Data Formats 25
2.5.2 Memory Data Formats 27
2.6 Instruction Set 28
2.6.1 Instruction Set Overview 28
2.6.2 Instructions and Addressing Modes 29
2.6.3 Tables of Instructions Classified by Function 30
2.6.4 Basic Instruction Formats 39
2.6.5 Notes on Use of Bit Manipulation Instructions 40
2.7 Addressing Modes and Effective Address Calculation 42
2.7.1 Addressing Modes 42
2.7.2 Effective Address Calculation 44
2.8 Processing States 48
2.8.1 Overview 48
2.8.2 Program Execution State 49
2.8.3 Exception-Handling State 49
2.8.4 Exception-Handling Sequences 51
2.8.5 Bus-Released State 52
2.8.6 Reset State 52
2.8.7 Power-Down State 52

2.9 Basic Operational Timing 53
2.9.1 Overview 53
2.9.2 On-Chip Memory Access Timing 53
2.9.3 On-Chip Supporting Module Access Timing 54
2.9.4 Access to External Address Space 55

Section 3 MCU Operating Modes 57
3.1 Overview 57
3.1.1 Operating Mode Selection 57
3.1.2 Register Configuration 58
3.2 Mode Control Register (MDCR) 59
3.3 System Control Register (SYSCR) 60
3.4 Operating Mode Descriptions 62
3.4.1 Mode 1 62
3.4.2 Mode 2 62
3.4.3 Mode 3 62
3.4.4 Mode 4 63
3.4.5 Mode 5 63
3.4.6 Mode 7 63
3.5 Pin Functions in Each Operating Mode 64
3.6 Memory Map in Each Operating Mode 65
3.6.1 Note on Reserved Areas 65

Section 4 Exception Handling 71
4.1 Overview 71
4.1.1 Exception Handling Types and Priority 71
4.1.2 Exception Handling Operation 71
4.1.3 Exception Vector Table 72
4.2 Reset 74
4.2.1 Overview 74
4.2.2 Reset Sequence 74
4.2.3 Interrupts after Reset 76
4.3 Interrupts 77
4.4 Trap Instruction 78
4.5 Stack Status after Exception Handling 79
4.6 Notes on Stack Usage 80

Section 5 Interrupt Controller 83
5.1 Overview 83
5.1.1 Features 83
5.1.2 Block Diagram 84
5.1.3 Pin Configuration 85
5.1.4 Register Configuration 85

5.2 Register Descriptions 86
5.2.1 System Control Register (SYSCR) 86
5.2.2 Interrupt Priority Registers A and B (IPRA, IPRB) 87
5.2.3 IRQ Status Register (ISR) 94
5.2.4 IRQ Enable Register (IER) 95
5.2.5 IRQ Sense Control Register (ISCR) 96
5.3 Interrupt Sources 97
5.3.1 External Interrupts 97
5.3.2 Internal Interrupts 98
5.3.3 Interrupt Vector Table 98
5.4 Interrupt Operation 102
5.4.1 Interrupt Handling Process 102
5.4.2 Interrupt Sequence 107
5.4.3 Interrupt Response Time 108
5.5 Usage Notes 109
5.5.1 Contention between Interrupt and Interrupt-Disabling Instruction 109
5.5.2 Instructions that Inhibit Interrupts 110
5.5.3 Interrupts during EEPMOV Instruction Execution 110

Section 6 Bus Controller 111
6.1 Overview 111
6.1.1 Features 111
6.1.2 Block Diagram 113
6.1.3 Pin Configuration 114
6.1.4 Register Configuration 115
6.2 Register Descriptions 116
6.2.1 Bus Width Control Register (ABWCR) 116
6.2.2 Access State Control Register (ASTCR) 117
6.2.3 Wait Control Registers H and L (WCRH, WCRL) 117
6.2.4 Bus Release Control Register (BRCR) 121
6.2.5 Bus Control Register (BCR) 122
6.2.6 Chip Select Control Register (CSCR) 126
6.2.7 DRAM Control Register A (DRCRA) 127
6.2.8 DRAM Control Register B (DRCRB) 129
6.2.9 Refresh Timer Control/Status Register (RTMCSR) 131
6.2.10 Refresh Timer Counter (RTCNT) 133
6.2.11 Refresh Time Constant Register (RTCOR) 133
6.2.12 Address Control Register (ADRCR) 134
6.3 Operation 135
6.3.1 Area Division 135
6.3.2 Bus Specifications 137
6.3.3 Memory Interfaces 138
6.3.4 Chip Select Signals 139

6.3.5 Address Output Method 140
6.4 Basic Bus Interface 142
6.4.1 Overview 142
6.4.2 Data Size and Data Alignment 142
6.4.3 Valid Strobes 143
6.4.4 Memory Areas 144
6.4.5 Basic Bus Control Signal Timing 146
6.4.6 Wait Control 153
6.5 DRAM Interface 155
6.5.1 Overview 155
6.5.2 DRAM Space and $\overline{\text{RAS}}$ Output Pin Settings 155
6.5.3 Address Multiplexing 156
6.5.4 Data Bus 157
6.5.5 Pins Used for DRAM Interface 157
6.5.6 Basic Timing 158
6.5.7 Precharge State Control 159
6.5.8 Wait Control 160
6.5.9 Byte Access Control and $\overline{\text{CAS}}$ Output Pin 161
6.5.10 Burst Operation 163
6.5.11 Refresh Control 168
6.5.12 Examples of Use 172
6.5.13 Usage Notes 176
6.6 Interval Timer 179
6.6.1 Operation 179
6.7 Interrupt Sources 184
6.8 Burst ROM Interface 184
6.8.1 Overview 184
6.8.2 Basic Timing 184
6.8.3 Wait Control 185
6.9 Idle Cycle 186
6.9.1 Operation 186
6.9.2 Pin States in Idle Cycle 189
6.10 Bus Arbiter 190
6.10.1 Operation 190
6.11 Register and Pin Input Timing 193
6.11.1 Register Write Timing 193
6.11.2 $\overline{\text{BREQ}}$ Pin Input Timing 194

Section 7 DMA Controller 195
7.1 Overview 195
7.1.1 Features 195
7.1.2 Block Diagram 196
7.1.3 Functional Overview 197

7.1.4 Input/Output Pins 198
7.1.5 Register Configuration 198
7.2 Register Descriptions (1) (Short Address Mode) 200
7.2.1 Memory Address Registers (MAR) 200
7.2.2 I/O Address Registers (IOAR) 201
7.2.3 Execute Transfer Count Registers (ETCR) 201
7.2.4 Data Transfer Control Registers (DTCR) 203
7.3 Register Descriptions (2) (Full Address Mode) 206
7.3.1 Memory Address Registers (MAR) 206
7.3.2 I/O Address Registers (IOAR) 206
7.3.3 Execute Transfer Count Registers (ETCR) 207
7.3.4 Data Transfer Control Registers (DTCR) 209
7.4 Operation 215
7.4.1 Overview 215
7.4.2 I/O Mode 217
7.4.3 Idle Mode 219
7.4.4 Repeat Mode 222
7.4.5 Normal Mode 225
7.4.6 Block Transfer Mode 228
7.4.7 DMAC Activation 233
7.4.8 DMAC Bus Cycle 235
7.4.9 Multiple-Channel Operation 241
7.4.10 External Bus Requests, DRAM Interface, and DMAC 242
7.4.11 NMI Interrupts and DMAC 243
7.4.12 Aborting a DMAC Transfer 244
7.4.13 Exiting Full Address Mode 245
7.4.14 DMAC States in Reset State, Standby Modes, and Sleep Mode 246
7.5 Interrupts 247
7.6 Usage Notes 248
7.6.1 Note on Word Data Transfer 248
7.6.2 DMAC Self-Access 248
7.6.3 Longword Access to Memory Address Registers 248
7.6.4 Note on Full Address Mode Setup 248
7.6.5 Note on Activating DMAC by Internal Interrupts 249
7.6.6 NMI Interrupts and Block Transfer Mode 250
7.6.7 Memory and I/O Address Register Values 250
7.6.8 Bus Cycle when Transfer is Aborted 251
7.6.9 Transfer Requests by A/D Converter 251

Section 8 I/O Ports 253
8.1 Overview 253
8.2 Port 1 256
8.2.1 Overview 256

8.2.2 Register Descriptions 257
8.3 Port 2 259
8.3.1 Overview 259
8.3.2 Register Descriptions 260
8.4 Port 3 263
8.4.1 Overview 263
8.4.2 Register Descriptions 263
8.5 Port 4 265
8.5.1 Overview 265
8.5.2 Register Descriptions 266
8.6 Port 5 269
8.6.1 Overview 269
8.6.2 Register Descriptions 269
8.7 Port 6 273
8.7.1 Overview 273
8.7.2 Register Descriptions 274
8.8 Port 7 277
8.8.1 Overview 277
8.8.2 Register Description 278
8.9 Port 8 279
8.9.1 Overview 279
8.9.2 Register Descriptions 281
8.10 Port 9 285
8.10.1 Overview 285
8.10.2 Register Descriptions 286
8.11 Port A 290
8.11.1 Overview 290
8.11.2 Register Descriptions 292
8.12 Port B 301
8.12.1 Overview 301
8.12.2 Register Descriptions 303

Section 9 16-Bit Timer 311
9.1 Overview 311
9.1.1 Features 311
9.1.2 Block Diagrams 313
9.1.3 Pin Configuration 316
9.1.4 Register Configuration 317
9.2 Register Descriptions 318
9.2.1 Timer Start Register (TSTR) 318
9.2.2 Timer Synchro Register (TSNC) 319
9.2.3 Timer Mode Register (TMDR) 320
9.2.4 Timer Interrupt Status Register A (TISRA) 323

9.2.5 Timer Interrupt Status Register B (TISRB) 326
9.2.6 Timer Interrupt Status Register C (TISRC) 329
9.2.7 Timer Counters (16TCNT) 331
9.2.8 General Registers (GRA, GRB) 332
9.2.9 Timer Control Registers (16TCR) 333
9.2.10 Timer I/O Control Register (TIOR) 335
9.2.11 Timer Output Level Setting Register C (TOLR) 337
9.3 CPU Interface 339
9.3.1 16-Bit Accessible Registers 339
9.3.2 8-Bit Accessible Registers 341
9.4 Operation 342
9.4.1 Overview 342
9.4.2 Basic Functions 342
9.4.3 Synchronization 350
9.4.4 PWM Mode 352
9.4.5 Phase Counting Mode 356
9.4.6 16-Bit Timer Output Timing 358
9.5 Interrupts 359
9.5.1 Setting of Status Flags 359
9.5.2 Timing of Clearing of Status Flags 361
9.5.3 Interrupt Sources 362
9.6 Usage Notes 363

Section 10 8-Bit Timers 375
10.1 Overview 375
10.1.1 Features 375
10.1.2 Block Diagram 377
10.1.3 Pin Configuration 378
10.1.4 Register Configuration 379
10.2 Register Descriptions 380
10.2.1 Timer Counters (8TCNT) 380
10.2.2 Time Constant Registers A (TCORA) 381
10.2.3 Time Constant Registers B (TCORB) 382
10.2.4 Timer Control Register (8TCR) 383
10.2.5 Timer Control/Status Registers (8TCSR) 386
10.3 CPU Interface 391
10.3.1 8-Bit Registers 391
10.4 Operation 393
10.4.1 8TCNT Count Timing 393
10.4.2 Compare Match Timing 394
10.4.3 Input Capture Signal Timing 395
10.4.4 Timing of Status Flag Setting 396
10.4.5 Operation with Cascaded Connection 397

10.4.6 Input Capture Setting 400
10.5 Interrupt 401
10.5.1 Interrupt Sources 401
10.5.2 A/D Converter Activation 402
10.6 8-Bit Timer Application Example 402
10.7 Usage Notes 403
10.7.1 Contention between 8TCNT Write and Clear 403
10.7.2 Contention between 8TCNT Write and Increment 404
10.7.3 Contention between TCOR Write and Compare Match 405
10.7.4 Contention between TCOR Read and Input Capture 406
10.7.5 Contention between Counter Clearing by Input Capture and Counter Increment 407
10.7.6 Contention between TCOR Write and Input Capture 408
10.7.7 Contention between 8TCNT Byte Write and Increment in 16-Bit Count Mode (Cascaded Connection) 409
10.7.8 Contention between Compare Matches A and B 410
10.7.9 8TCNT Operation and Internal Clock Source Switchover 410

Section 11 Programmable Timing Pattern Controller (TPC) 413
11.1 Overview 413
11.1.1 Features 413
11.1.2 Block Diagram 414
11.1.3 TPC Pins 415
11.1.4 Registers 416
11.2 Register Descriptions 417
11.2.1 Port A Data Direction Register (PADDR) 417
11.2.2 Port A Data Register (PADR) 417
11.2.3 Port B Data Direction Register (PBDDR) 418
11.2.4 Port B Data Register (PBDR) 418
11.2.5 Next Data Register A (NDRA) 419
11.2.6 Next Data Register B (NDRB) 421
11.2.7 Next Data Enable Register A (NDERA) 423
11.2.8 Next Data Enable Register B (NDERB) 424
11.2.9 TPC Output Control Register (TPCR) 425
11.2.10 TPC Output Mode Register (TPMR) 428
11.3 Operation 430
11.3.1 Overview 430
11.3.2 Output Timing 431
11.3.3 Normal TPC Output 432
11.3.4 Non-Overlapping TPC Output 434
11.3.5 TPC Output Triggering by Input Capture 436
11.4 Usage Notes 437
11.4.1 Operation of TPC Output Pins 437

11.4.2 Note on Non-Overlapping Output 437

Section 12 Watchdog Timer 439
12.1 Overview 439
12.1.1 Features 439
12.1.2 Block Diagram 440
12.1.3 Register Configuration 440
12.2 Register Descriptions 441
12.2.1 Timer Counter (TCNT) 441
12.2.2 Timer Control/Status Register (TCSR) 442
12.2.3 Reset Control/Status Register (RSTCSR) 444
12.2.4 Notes on Register Access 445
12.3 Operation 447
12.3.1 Watchdog Timer Operation 447
12.3.2 Interval Timer Operation 448
12.3.3 Timing of Setting of Overflow Flag (OVF) 449
12.3.4 Timing of Setting of Watchdog Timer Reset Bit (WRST) 450
12.4 Interrupts 451
12.5 Usage Notes 451

Section 13 Serial Communication Interface 453
13.1 Overview 453
13.1.1 Features 453
13.1.2 Block Diagram 455
13.1.3 Input/Output Pins 456
13.1.4 Register Configuration 457
13.2 Register Descriptions 458
13.2.1 Receive Shift Register (RSR) 458
13.2.2 Receive Data Register (RDR) 458
13.2.3 Transmit Shift Register (TSR) 459
13.2.4 Transmit Data Register (TDR) 459
13.2.5 Serial Mode Register (SMR) 460
13.2.6 Serial Control Register (SCR) 464
13.2.7 Serial Status Register (SSR) 469
13.2.8 Bit Rate Register (BRR) 474
13.3 Operation 481
13.3.1 Overview 481
13.3.2 Operation in Asynchronous Mode 483
13.3.3 Multiprocessor Communication 493
13.3.4 Synchronous Operation 499
13.4 SCI Interrupts 508
13.5 Usage Notes 508
13.5.1 Notes on Use of SCI 508

Section 14 Smart Card Interface 515
14.1 Overview 515
14.1.1 Features 515
14.1.2 Block Diagram 516
14.1.3 Pin Configuration 516
14.1.4 Register Configuration 517
14.2 Register Descriptions 518
14.2.1 Smart Card Mode Register (SCMR) 518
14.2.2 Serial Status Register (SSR) 519
14.2.3 Serial Mode Register (SMR) 521
14.2.4 Serial Control Register (SCR) 522
14.3 Operation 522
14.3.1 Overview 522
14.3.2 Pin Connections 523
14.3.3 Data Format 524
14.3.4 Register Settings 525
14.3.5 Clock 527
14.3.6 Transmitting and Receiving Data 529
14.4 Usage Notes 537

Section 15 A/D Converter 541
15.1 Overview 541
15.1.1 Features 541
15.1.2 Block Diagram 542
15.1.3 Input Pins 543
15.1.4 Register Configuration 544
15.2 Register Descriptions 545
15.2.1 A/D Data Registers A to D (ADDRA to ADDRD) 545
15.2.2 A/D Control/Status Register (ADCSR) 546
15.2.3 A/D Control Register (ADCR) 549
15.3 CPU Interface 550
15.4 Operation 551
15.4.1 Single Mode (SCAN = 0) 551
15.4.2 Scan Mode (SCAN = 1) 553
15.4.3 Input Sampling and A/D Conversion Time 555
15.4.4 External Trigger Input Timing 556
15.5 Interrupts 557
15.6 Usage Notes 557

Section 16 D/A Converter 563
16.1 Overview 563
16.1.1 Features 563
16.1.2 Block Diagram 563

16.1.3 Input/Output Pins 564
16.1.4 Register Configuration 564
16.2 Register Descriptions 565
16.2.1 D/A Data Registers 0 and 1 (DADR0/1) 565
16.2.2 D/A Control Register (DACR) 565
16.2.3 D/A Standby Control Register (DASTCR) 567
16.3 Operation 568
16.4 D/A Output Control 569

Section 17 RAM 571
17.1 Overview 571
17.1.1 Block Diagram 571
17.1.2 Register Configuration 572
17.2 System Control Register (SYSCR) 572
17.3 Operation 573

Section 18 ROM 575
18.1 Features 575
18.2 Overview 577
18.2.1 Block Diagram 577
18.2.2 Operating Mode 578
18.2.3 Mode Comparison 579
18.2.4 Flash MAT Configuration 581
18.2.5 Block Division 581
18.2.6 Programming/Erasing Interface 582
18.3 Pin Configuration 585
18.4 Register Configuration 586
18.4.1 Registers 586
18.4.2 Programming/Erasing Interface Register 589
18.4.3 Programming/Erasing Interface Parameter 595
18.4.4 RAM Control Register (RAMCR) 606
18.4.5 Flash Vector Address Control Register (FVACR) 607
18.4.6 Flash Vector Address Data Register (FVADR) 609
18.5 On-Board Programming Mode 610
18.5.1 Boot Mode 610
18.5.2 User Program Mode 613
18.5.3 User Boot Mode 624
18.6 Protection 628
18.6.1 Hardware Protection 628
18.6.2 Software Protection 629
18.6.3 Error Protection 630
18.7 Flash Memory Emulation in RAM 632
18.8 Switching between User MAT and User Boot MAT 635

18.8.1 Usage Notes 636
18.9 PROM Mode 637
18.9.1 Pin Arrangement of the Socket Adapter 637
18.9.2 PROM Mode Operation 639
18.9.3 Memory-Read Mode 640
18.9.4 Auto-Program Mode 641
18.9.5 Auto-Erase Mode 641
18.9.6 Status-Read Mode 642
18.9.7 Status Polling 642
18.9.8 Time Taken in Transition to PROM Mode 643
18.9.9 Notes on Using PROM Mode 643
18.10 Further Information 644
18.10.1 Serial Communication Interface Specification for Boot Mode 644
18.10.2 AC Characteristics and Timing in Writer Mode 670
18.10.3 Procedure Program and Storable Area for Programming Data 676

Section 19 Clock Pulse Generator 687
19.1 Overview 687
19.1.1 Block Diagram 687
19.2 Oscillator Circuit 688
19.2.1 Connecting a Crystal Resonator 688
19.2.2 External Clock Input 690
19.3 Duty Adjustment Circuit 692
19.4 Prescalers 692
19.5 Frequency Divider 692
19.5.1 Register Configuration 693
19.5.2 Division Control Register (DIVCR) 693
19.5.3 Usage Notes 694

Section 20 Power-Down State 695
20.1 Overview 695
20.2 Register Configuration 697
20.2.1 System Control Register (SYSCR) 697
20.2.2 Module Standby Control Register H (MSTCRH) 699
20.2.3 Module Standby Control Register L (MSTCRL) 700
20.3 Sleep Mode 702
20.3.1 Transition to Sleep Mode 702
20.3.2 Exit from Sleep Mode 702
20.4 Software Standby Mode 703
20.4.1 Transition to Software Standby Mode 703
20.4.2 Exit from Software Standby Mode 703
20.4.3 Selection of Waiting Time for Exit from Software Standby Mode 704
20.4.4 Sample Application of Software Standby Mode 705

20.4.5 Note 705
20.5 Hardware Standby Mode 706
20.5.1 Transition to Hardware Standby Mode 706
20.5.2 Exit from Hardware Standby Mode 706
20.5.3 Timing for Hardware Standby Mode 706
20.5.4 Timing for Hardware Standby Mode at Power-On 707
20.6 Module Standby Function 708
20.6.1 Module Standby Timing 708
20.6.2 Read/Write in Module Standby 708
20.6.3 Usage Notes 708
20.7 System Clock Output Disabling Function 709

Section 21 Electrical Characteristics 711
21.1 Electrical Characteristics of HD64F3069RF25 and HD64F3069RTE25 711
21.1.1 Absolute Maximum Ratings 711
21.1.2 DC Characteristics 712
21.1.3 AC Characteristics 717
21.1.4 A/D Conversion Characteristics 723
21.1.5 D/A Conversion Characteristics 724
21.1.6 Flash Memory Characteristics 725
21.2 Electrical Characteristics of HD64F3069RF25W and HD64F3069RTE25W 726
21.2.1 Absolute Maximum Ratings 726
21.2.2 DC Characteristics 727
21.2.3 AC Characteristics 732
21.2.4 A/D Conversion Characteristics 738
21.2.5 D/A Conversion Characteristics 739
21.2.6 Flash Memory Characteristics 740
21.3 Electrical Characteristics of HD64F3069RFBL25 and HD64F3069RTEBL25 741
21.3.1 Absolute Maximum Ratings 741
21.3.2 DC Characteristics 742
21.3.3 AC Characteristics 747
21.3.4 A/D Conversion Characteristics 753
21.3.5 D/A Conversion Characteristics 754
21.3.6 Flash Memory Characteristics 755
21.4 Operational Timing 756
21.4.1 Clock Timing 756
21.4.2 Control Signal Timing 757
21.4.3 Bus Timing 758
21.4.4 DRAM Interface Bus Timing 764
21.4.5 TPC and I/O Port Timing 767
21.4.6 Timer Input/Output Timing 768
21.4.7 SCI Input/Output Timing 769
21.4.8 DMAC Timing 770

21.5 Usage Notes 771

Appendix A Instruction Set 773
A.1 Instruction List 773
A.2 Operation Code Maps 788
A.3 Number of States Required for Execution 791

Appendix B Internal I/O Registers 800
B.1 Addresses (EMC = 1) 800
B.2 Addresses (EMC = 0) 813
B.3 Functions 825

Appendix C I/O Port Block Diagrams 921
C.1 Port 1 Block Diagram 921
C.2 Port 2 Block Diagram 922
C.3 Port 3 Block Diagram 923
C.4 Port 4 Block Diagram 924
C.5 Port 5 Block Diagram 925
C.6 Port 6 Block Diagrams 926
C.7 Port 7 Block Diagrams 933
C.8 Port 8 Block Diagrams 934
C.9 Port 9 Block Diagrams 939
C.10 Port A Block Diagrams 945
C.11 Port B Block Diagrams 948

Appendix D Pin States 956
D.1 Port States in Each Mode 956
D.2 Pin States at Reset 963

Appendix E Timing of Transition to and Recovery from Hardware Standby Mode 966

Appendix F Product Code Lineup 967
F.1 H8/3069R Product Code Lineup 967

Appendix G Package Dimensions 968

Appendix H Comparison of H8/300H Series Product Specifications 970
H.1 Differences between H8/3069R and H8/3029, H8/3067 Group and H8/3062 Group, H8/3048 Group, H8/3007 and H8/3006, and H8/3002 970
H.2 Comparison of Pin Functions of 100-Pin Package Products (FP-100B, TFP-100B) 974

Section 1 Overview

1.1 Overview

The H8/3069R is a series of microcontrollers (MCUs) that integrate system supporting functions together with an H8/300H CPU core having an original Renesas Technology architecture.

The H8/300H CPU has a 32-bit internal architecture with sixteen 16-bit general registers, and a concise, optimized instruction set designed for speed. It can address a 16-Mbyte linear address space. Its instruction set is upward-compatible at the object-code level with the H8/300 CPU, enabling easy porting of software from the H8/300 Series.

The on-chip system supporting functions include ROM, RAM, a 16-bit timer, an 8-bit timer, a programmable timing pattern controller (TPC), a watchdog timer (WDT), a serial communication interface (SCI), an A/D converter, a D/A converter, I/O ports, a direct memory access controller (DMAC), and other facilities.

The H8/3069R has 512 kbytes of flash memory and 16 kbytes of RAM.

Six MCU operating modes offer a choice of bus width and address space size. The modes (modes 1 to 5, 7) include one single-chip mode and five expanded modes.

The H8/3069R includes an F-ZTAT™* version with on-chip flash memory that can be programmed on-board. This version enables users to respond quickly and flexibly to changing application specifications, growing production volumes, and other conditions.

Table 1.1 summarizes the features of the H8/3069R.

Note: * F-ZTAT (Flexible ZTAT) is a trademark of Renesas Technology Corp.

Table 1.1 Features

Feature	Description
CPU	Upward-compatible with the H8/300 CPU at the object-code level General-register machine • Sixteen 16-bit general registers (also usable as sixteen 8-bit registers, eight 16-bit registers, or eight 32-bit registers) High-speed operation • Maximum clock rate: 25 MHz • Add/subtract: 80 ns • Multiply/divide: 560 ns 16-Mbyte address space Instruction features • 8/16/32-bit data transfer, arithmetic, and logic instructions • Signed and unsigned multiply instructions (8 bits x 8 bits, 16 bits x 16 bits) • Signed and unsigned divide instructions (16 bits ÷ 8 bits, 32 bits ÷ 16 bits) • Bit accumulator function • Bit manipulation instructions with register-indirect specification of bit positions
Memory	H8/3069R • ROM: 512 kbytes • RAM: 16 kbytes
Interrupt controller	• Seven external interrupt pins: NMI, $\overline{\text{IRQ}}$0 to $\overline{\text{IRQ}}$5 • 36 internal interrupts • Three selectable interrupt priority levels
Bus controller	• Address space can be partitioned into eight areas, with independent bus specifications in each area • Chip select output available for areas 0 to 7 • 8-bit access or 16-bit access selectable for each area • Two-state or three-state access selectable for each area • Selection of two wait modes • Number of program wait states selectable for each area • Direct connection of burst ROM • Direct connection of up to 8-Mbyte DRAM (or DRAM interface can be used as interval timer) • Bus arbitration function

Feature	Description
DMA controller (DMAC)	Short address mode • Maximum four channels available • Selection of I/O mode, idle mode, or repeat mode • Can be activated by compare match/input capture A interrupts from 16-bit timer channels 0 to 2, conversion-end interrupts from the A/D converter, transmit-data-empty and receive-data-full interrupts from the SCI, or external requests Full address mode • Maximum two channels available • Selection of normal mode or block transfer mode • Can be activated by compare match/input capture A interrupts from 16-bit timer channels 0 to 2, conversion-end interrupts from the A/D converter, external requests, or auto-request
16-bit timer, 3 channels	• Three 16-bit timer channels, capable of processing up to six pulse outputs or six pulse inputs • 16-bit timer counter (channels 0 to 2) • Two multiplexed output compare/input capture pins (channels 0 to 2) • Operation can be synchronized (channels 0 to 2) • PWM mode available (channels 0 to 2) • Phase counting mode available (channel 2) • DMAC can be activated by compare match/input capture A interrupts (channels 0 to 2)
8-bit timer, 4 channels	• 8-bit up-counter (external event count capability) • Two time constant registers • Two channels can be connected
Programmable timing pattern controller (TPC)	• Maximum 16-bit pulse output, using 16-bit timer as time base • Up to four 4-bit pulse output groups (or one 16-bit group, or two 8-bit groups) • Non-overlap mode available • Output data can be transferred by DMAC
Watchdog timer (WDT), 1 channel	• Reset signal can be generated by overflow • Usable as an interval timer
Serial communication interface (SCI), 3 channels	• Selection of asynchronous or synchronous mode • Full duplex: can transmit and receive simultaneously • On-chip baud-rate generator • Smart card interface functions added

<table>
<tr><th>Feature</th><th>Description</th></tr>
<tr><td>A/D converter</td><td>• Resolution: 10 bits
• Eight channels, with selection of single or scan mode
• Variable analog conversion voltage range
• Sample-and-hold function
• A/D conversion can be started by an external trigger or 8-bit timer compare-match
• DMAC can be activated by an A/D conversion end interrupt</td></tr>
<tr><td>D/A converter</td><td>• Resolution: 8 bits
• Two channels
• D/A outputs can be sustained in software standby mode</td></tr>
<tr><td>I/O ports</td><td>• 70 input/output pins
• 9 input-only pins</td></tr>
<tr><td>Operating modes</td><td>• Six MCU operating modes
<table>
<tr><th>Mode</th><th>Address Space</th><th>Address Pins</th><th>Initial Bus Width</th><th>Max. Bus Width</th></tr>
<tr><td>Mode 1</td><td>1 Mbyte</td><td>A_{19} to A_0</td><td>8 bits</td><td>16 bits</td></tr>
<tr><td>Mode 2</td><td>1 Mbyte</td><td>A_{19} to A_0</td><td>16 bits</td><td>16 bits</td></tr>
<tr><td>Mode 3</td><td>16 Mbytes</td><td>A_{23} to A_0</td><td>8 bits</td><td>16 bits</td></tr>
<tr><td>Mode 4</td><td>16 Mbytes</td><td>A_{23} to A_0</td><td>16 bits</td><td>16 bits</td></tr>
<tr><td>Mode 5</td><td>16 Mbytes</td><td>A_{23} to A_0</td><td>8 bits</td><td>16 bits</td></tr>
<tr><td>Mode 7</td><td>1 Mbyte</td><td>—</td><td>—</td><td>—</td></tr>
</table>
• On-chip ROM is disabled in modes 1 to 4</td></tr>
<tr><td>Power-down state</td><td>• Sleep mode
• Software standby mode
• Hardware standby mode
• Module standby function
• Programmable system clock frequency division</td></tr>
<tr><td>Other features</td><td>• On-chip clock pulse generator</td></tr>
</table>

Feature	Description				
Product lineup	**Group**	**Product Code (Catalog Product Code)**	**Regular Product Code (Internal Product Code)**	**Package (Package Code)**	**Classification**
	H8/3069R	HD64F3069RF25	HD64F3069RF25	100-pin QFP (FP-100B)	Regular specifications with on-chip flash memory
		HD64F3069RF25W	HD64F3069RF25W		Wide-range specifications with on-chip flash memory
		HD64F3069RFBL25	HD64F3069RFBL25		Standard characteristic specifications with on-chip flash memory
		HD64F3069RTE25	HD64F3069RX25	100-pin TQFP (TFP-100B)	Regular specifications with on-chip flash memory
		HD64F3069RTE25W	HD64F3069RX25W		Wide-range specifications with on-chip flash memory
		HD64F3069RTEBL25	HD64F3069RXBL25		Standard characteristic specifications with on-chip flash memory

1.2 Block Diagram

Figure 1.1 shows an internal block diagram.

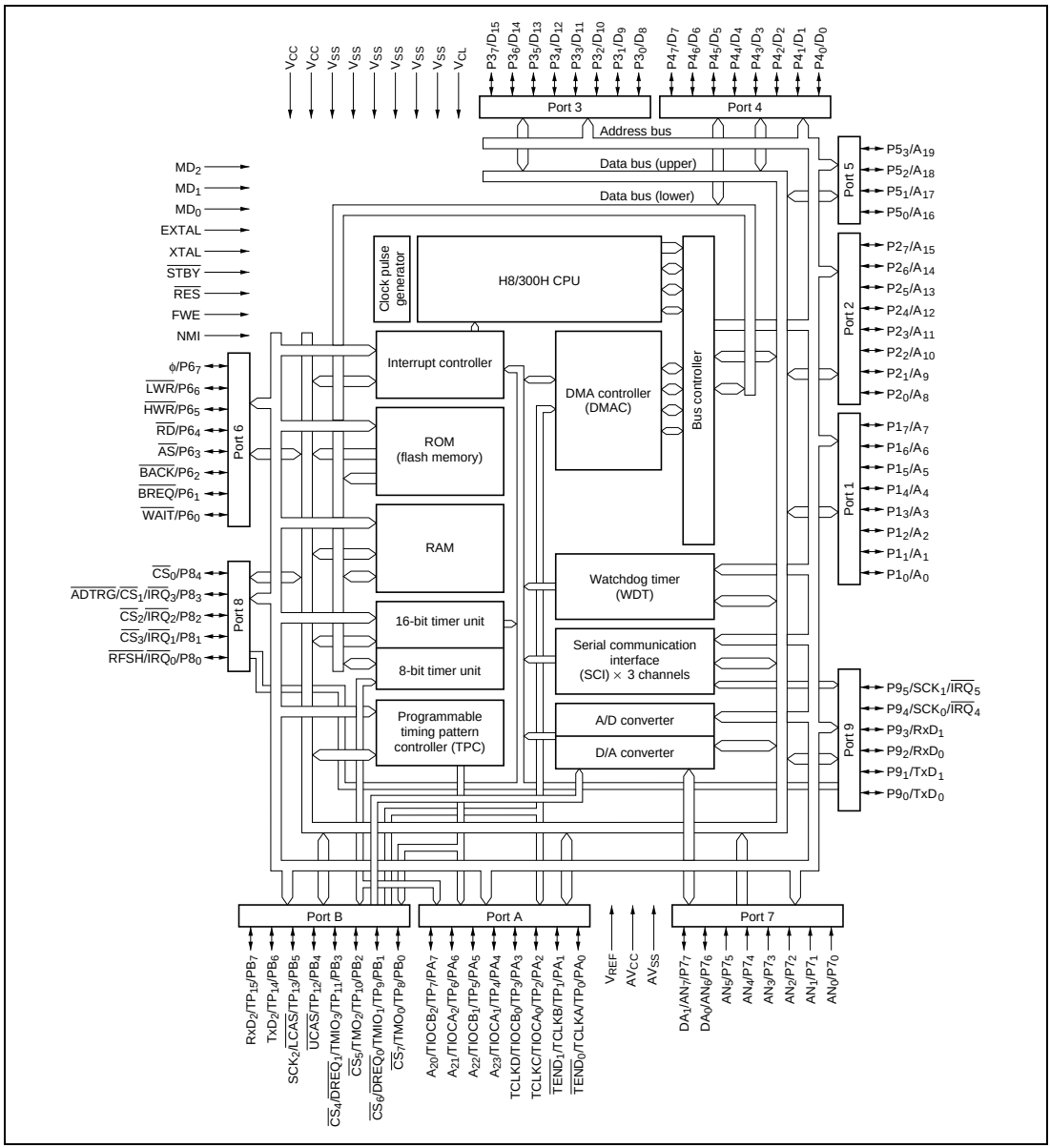
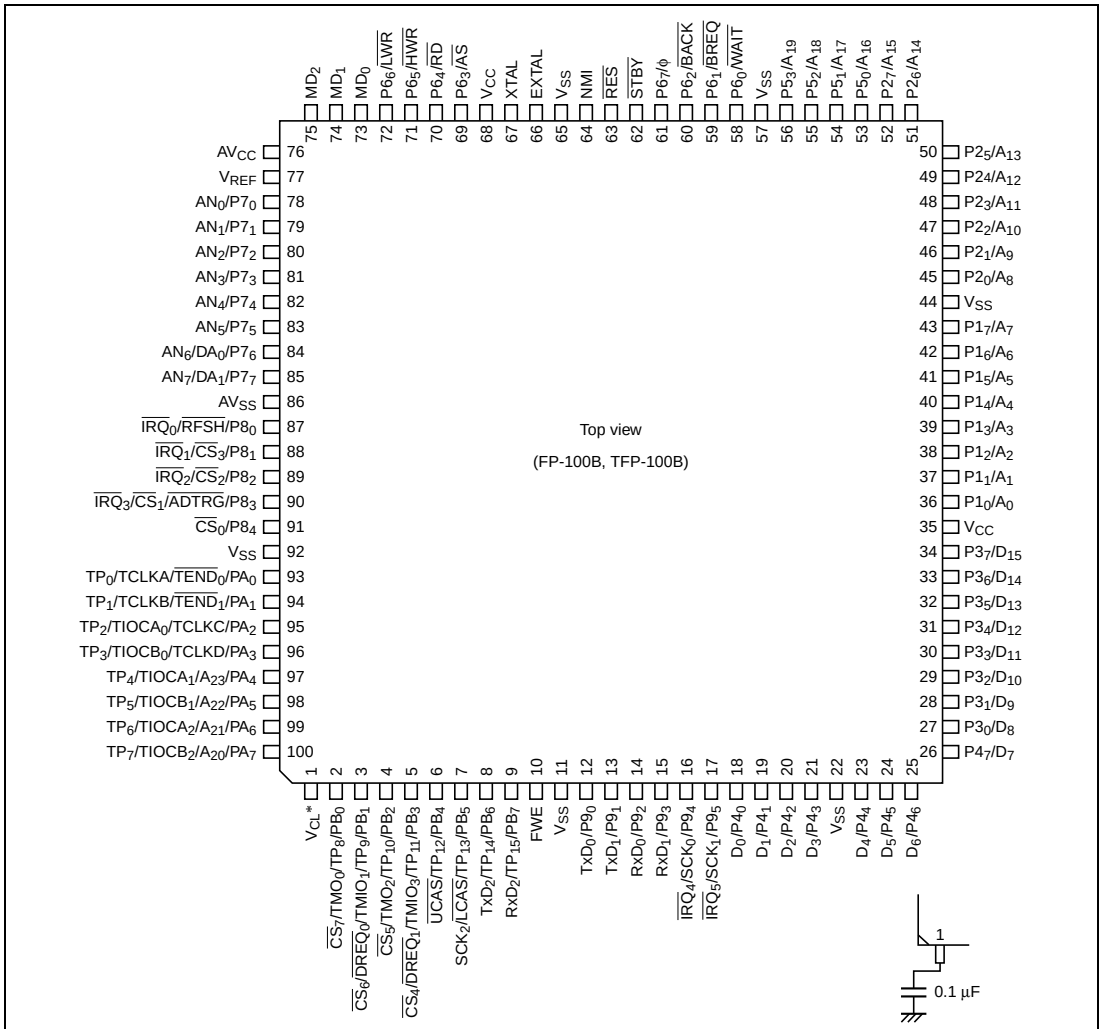


Figure 1.1 Block Diagram

1.3 Pin Description

1.3.1 Pin Arrangement

The pin arrangement of the H8/3069R FP-100B and TFP-100B packages is shown in figure 1.2.



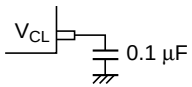
Note: * When functioning as V_{CL} pin, the connection of an external capacitor is required.

Figure 1.2 Pin Arrangement (FP-100B or TFP-100B, Top View)

1.3.2 Pin Functions

Table 1.2 summarizes the pin functions.

Table 1.2 Pin Functions

Type	Symbol	Pin No. FP-100B TFP-100B	I/O	Name and Function
Power	V_{CC}	35, 68	Input	**Power:** For connection to the power supply. Connect all V_{CC} pins to the system power supply.
	V_{SS}	11, 22, 44, 57, 65, 92	Input	**Ground:** For connection to ground (0 V). Connect all V_{SS} pins to the 0-V system power supply.
Internal step-down pin	V_{CL}	1	Output	Connect an external capacitor between this pin and GND (0 V). Do not connect to V_{CC}. 
Clock	XTAL	67	Input	For connection to a crystal resonator. For examples of crystal resonator and external clock input, see section 19, Clock Pulse Generator.
	EXTAL	66	Input	For connection to a crystal resonator or input of an external clock signal. For examples of crystal resonator and external clock input, see section 19, Clock Pulse Generator.
	ϕ	61	Output	**System clock:** Supplies the system clock to external devices.

Type	Symbol	Pin No. FP-100B TFP-100B	I/O	Name and Function
Operating mode control	MD_2 to MD_0	75 to 73	Input	**Mode 2 to mode 0:** For setting the operating mode, as follows. The H8/3069R can be used only in modes 1 to 5, 7. The inputs at the mode pins must select one of these six modes. Inputs at these pins must not be changed during operation.

MD_2	MD_1	MD_0	Operating Mode
0	0	0	—
0	0	1	Mode 1
0	1	0	Mode 2
0	1	1	Mode 3
1	0	0	Mode 4
1	0	1	Mode 5
1	1	0	—
1	1	1	Mode 7

Type	Symbol	Pin No. FP-100B TFP-100B	I/O	Name and Function
System control	$\overline{RES}$	63	Input	**Reset input:** When driven low, this pin resets the chip
	FWE	10	Input	**Write enable signal:** Flash memory write control signal
	$\overline{STBY}$	62	Input	**Standby:** When driven low, this pin forces a transition to hardware standby mode
	$\overline{BREQ}$	59	Input	**Bus request:** Used by an external bus master to request the bus right
	$\overline{BACK}$	60	Output	**Bus request acknowledge:** Indicates that the bus has been granted to an external bus master
Interrupts	NMI	64	Input	**Nonmaskable interrupt:** Requests a nonmaskable interrupt
	$\overline{IRQ_5}$ to $\overline{IRQ_0}$	17, 16, 90 to 87	Input	**Interrupt request 5 to 0:** Maskable interrupt request pins
Address bus	A_{23} to A_0	97 to 100, 56 to 45, 43 to 36	Output	**Address bus:** Outputs address signals

Type	Symbol	Pin No. FP-100B TFP-100B	I/O	Name and Function
Data bus	D_{15} to D_0	34 to 23, 21 to 18	Input/ output	**Data bus:** Bidirectional data bus
Bus control	$\overline{CS}_7$ to $\overline{CS}_0$	2 to 5, 88 to 91	Output	**Chip select:** Select signals for areas 7 to 0
	$\overline{AS}$	69	Output	**Address strobe:** Goes low to indicate valid address output on the address bus
	$\overline{RD}$	70	Output	**Read:** Goes low to indicate reading from the external address space
	$\overline{HWR}$	71	Output	**High write:** Goes low to indicate writing to the external address space; indicates valid data on the upper data bus (D_{15} to D_8).
	$\overline{LWR}$	72	Output	**Low write:** Goes low to indicate writing to the external address space; indicates valid data on the lower data bus (D_7 to D_0).
	$\overline{WAIT}$	58	Input	**Wait:** Requests insertion of wait states in bus cycles during access to the external address space
DRAM interface	$\overline{RFSH}$	87	Output	**Refresh:** Indicates a refresh cycle
	$\overline{CS}_2$ to $\overline{CS}_5$	89, 88, 5, 4	Output	**Row address strobe $\overline{RAS}$:** Row address strobe signal for DRAM
	$\overline{RD}$	70	Output	**Write enable $\overline{WE}$:** Write enable signal for DRAM
	$\overline{HWR}$ $\overline{UCAS}$	71 6	Output	**Upper column address strobe $\overline{UCAS}$:** Column address strobe signal for DRAM
	$\overline{LWR}$ $\overline{LCAS}$	72 7	Output	**Lower column address strobe $\overline{LCAS}$:** Column address strobe signal for DRAM
DMA controller (DMAC)	$\overline{DREQ}_1$, $\overline{DREQ}_0$	5, 3	Input	**DMA request 1 and 0:** DMAC activation requests
	$\overline{TEND}_1$, $\overline{TEND}_0$	94, 93	Output	**Transfer end 1 and 0:** These signals indicate that the DMAC has ended a data transfer

Type	Symbol	Pin No. FP-100B TFP-100B	I/O	Name and Function
16-bit timer	TCLKD to TCLKA	96 to 93	Input	**Clock input D to A:** External clock inputs
	$TIOCA_2$ to $TIOCA_0$	99, 97, 95	Input/ output	**Input capture/output compare A2 to A0:** GRA2 to GRA0 output compare or input capture, or PWM output
	$TIOCB_2$ to $TIOCB_0$	100, 98, 96	Input/ output	**Input capture/output compare B2 to B0:** GRB2 to GRB0 output compare or input capture, or PWM output
8-bit timer	TMO_0, TMO_2	2, 4	Output	**Compare match output:** Compare match output pins
	$TMIO_1$, $TMIO_3$	3, 5	Input/ output	**Input capture input/compare match output:** Input capture input or compare match output pins
	TCLKD to TCLKA	96 to 93	Input	**Counter external clock input:** These pins input an external clock to the counters.
Programmable timing pattern controller (TPC)	TP_{15} to TP_0	9 to 2, 100 to 93	Output	**TPC output 15 to 0:** Pulse output
Serial communication interface (SCI)	TxD_2 to TxD_0	8, 13, 12	Output	**Transmit data (channels 0, 1, 2):** SCI data output
	RxD_2 to RxD_0	9, 15, 14	Input	**Receive data (channels 0, 1, 2):** SCI data input
	SCK_2 to SCK_0	7, 17, 16	Input/ output	**Serial clock (channels 0, 1, 2):** SCI clock input/output
A/D converter	AN_7 to AN_0	85 to 78	Input	**Analog 7 to 0:** Analog input pins
	$\overline{ADTRG}$	90	Input	**A/D conversion external trigger input:** External trigger input for starting A/D conversion
D/A converter	DA_1, DA_0	85, 84	Output	**Analog output:** Analog output from the D/A converter

Type	Symbol	Pin No. FP-100B TFP-100B	I/O	Name and Function
A/D and D/A converters	AV_{CC}	76	Input	Power supply pin for the A/D and D/A converters. Connect to the system power supply when not using the A/D and D/A converters.
	AV_{SS}	86	Input	Ground pin for the A/D and D/A converters. Connect to system ground (0 V).
	V_{REF}	77	Input	Reference voltage input pin for the A/D and D/A converters. Connect to the system power supply when not using the A/D and D/A converters.
I/O ports	$P1_7$ to $P1_0$	43 to 36	Input/ output	**Port 1:** Eight input/output pins. The direction of each pin can be selected in the port 1 data direction register (P1DDR).
	$P2_7$ to $P2_0$	52 to 45	Input/ output	**Port 2:** Eight input/output pins. The direction of each pin can be selected in the port 2 data direction register (P2DDR).
	$P3_7$ to $P3_0$	34 to 27	Input/ output	**Port 3:** Eight input/output pins. The direction of each pin can be selected in the port 3 data direction register (P3DDR).
	$P4_7$ to $P4_0$	26 to 23, 21 to 18	Input/ output	**Port 4:** Eight input/output pins. The direction of each pin can be selected in the port 4 data direction register (P4DDR).
	$P5_3$ to $P5_0$	56 to 53	Input/ output	**Port 5:** Four input/output pins. The direction of each pin can be selected in the port 5 data direction register (P5DDR).
	$P6_7$ to $P6_0$	61, 72 to 69, 60 to 58	Input/ output	**Port 6:** Seven input/output pins and one input pin. The direction of each pin can be selected in the port 6 data direction register (P6DDR).
	$P7_7$ to $P7_0$	85 to 78	Input	**Port 7:** Eight input pins
	$P8_4$ to $P8_0$	91 to 87	Input/ output	**Port 8:** Five input/output pins. The direction of each pin can be selected in the port 8 data direction register (P8DDR).
	$P9_5$ to $P9_0$	17 to 12	Input/ output	**Port 9:** Six input/output pins. The direction of each pin can be selected in the port 9 data direction register (P9DDR).
	PA_7 to PA_0	100 to 93	Input/ output	**Port A:** Eight input/output pins. The direction of each pin can be selected in the port A data direction register (PADDR).
	PB_7 to PB_0	9 to 2	Input/ output	**Port B:** Eight input/output pins. The direction of each pin can be selected in the port B data direction register (PBDDR).

1.3.3 Pin Assignments in Each Mode

Table 1.3 lists the pin assignments in each mode.

Table 1.3 Pin Assignments in Each Mode (FP-100B or TFP-100B)

Pin No.	Pin Name					
FP-100B TFP-100B	Mode 1	Mode 2	Mode 3	Mode 4	Mode 5	Mode 7
1	V_{CL}	V_{CL}	V_{CL}	V_{CL}	V_{CL}	V_{CL}
2	$PB_0/TP_8/TMO_0/\overline{CS_7}$	$PB_0/TP_8/TMO_0/\overline{CS_7}$	$PB_0/TP_8/TMO_0/\overline{CS_7}$	$PB_0/TP_8/TMO_0/\overline{CS_7}$	$PB_0/TP_8/TMO_0/\overline{CS_7}$	$PB_0/TP_8/TMO_0$
3	$PB_1/TP_9/TMIO_1/\overline{DREQ_0}/\overline{CS_6}$	$PB_1/TP_9/TMIO_1/\overline{DREQ_0}/\overline{CS_6}$	$PB_1/TP_9/TMIO_1/\overline{DREQ_0}/\overline{CS_6}$	$PB_1/TP_9/TMIO_1/\overline{DREQ_0}/\overline{CS_6}$	$PB_1/TP_9/TMIO_1/\overline{DREQ_0}/\overline{CS_6}$	$PB_1/TP_9/TMIO_1/\overline{DREQ_0}$
4	$PB_2/TP_{10}/TMO_2/\overline{CS_5}$	$PB_2/TP_{10}/TMO_2/\overline{CS_5}$	$PB_2/TP_{10}/TMO_2/\overline{CS_5}$	$PB_2/TP_{10}/TMO_2/\overline{CS_5}$	$PB_2/TP_{10}/TMO_2/\overline{CS_5}$	$PB_2/TP_{10}/TMO_2$
5	$PB_3/TP_{11}/TMIO_3/\overline{DREQ_1}/\overline{CS_4}$	$PB_3/TP_{11}/TMIO_3/\overline{DREQ_1}/\overline{CS_4}$	$PB_3/TP_{11}/TMIO_3/\overline{DREQ_1}/\overline{CS_4}$	$PB_3/TP_{11}/TMIO_3/\overline{DREQ_1}/\overline{CS_4}$	$PB_3/TP_{11}/TMIO_3/\overline{DREQ_1}/\overline{CS_4}$	$PB_3/TP_{11}/TMIO_3/\overline{DREQ_1}$
6	$PB_4/TP_{12}/\overline{UCAS}$	$PB_4/TP_{12}/\overline{UCAS}$	$PB_4/TP_{12}/\overline{UCAS}$	$PB_4/TP_{12}/\overline{UCAS}$	$PB_4/TP_{12}/\overline{UCAS}$	PB_4/TP_{12}
7	$PB_5/TP_{13}/\overline{LCAS}/SCK_2$	$PB_5/TP_{13}/\overline{LCAS}/SCK_2$	$PB_5/TP_{13}/\overline{LCAS}/SCK_2$	$PB_5/TP_{13}/\overline{LCAS}/SCK_2$	$PB_5/TP_{13}/\overline{LCAS}/SCK_2$	$PB_5/TP_{13}/SCK_2$
8	$PB_6/TP_{14}/TxD_2$	$PB_6/TP_{14}/TxD_2$	$PB_6/TP_{14}/TxD_2$	$PB_6/TP_{14}/TxD_2$	$PB_6/TP_{14}/TxD_2$	$PB_6/TP_{14}/TxD_2$
9	$PB_7/TP_{15}/RxD_2$	$PB_7/TP_{15}/RxD_2$	$PB_7/TP_{15}/RxD_2$	$PB_7/TP_{15}/RxD_2$	$PB_7/TP_{15}/RxD_2$	$PB_7/TP_{15}/RxD_2$
10	FWE	FWE	FWE	FWE	FWE	FWE
11	V_{SS}	V_{SS}	V_{SS}	V_{SS}	V_{SS}	V_{SS}
12	$P9_0/TxD_0$	$P9_0/TxD_0$	$P9_0/TxD_0$	$P9_0/TxD_0$	$P9_0/TxD_0$	$P9_0/TxD_0$
13	$P9_1/TxD_1$	$P9_1/TxD_1$	$P9_1/TxD_1$	$P9_1/TxD_1$	$P9_1/TxD_1$	$P9_1/TxD_1$
14	$P9_2/RxD_0$	$P9_2/RxD_0$	$P9_2/RxD_0$	$P9_2/RxD_0$	$P9_2/RxD_0$	$P9_2/RxD_0$
15	$P9_3/RxD_1$	$P9_3/RxD_1$	$P9_3/RxD_1$	$P9_3/RxD_1$	$P9_3/RxD_1$	$P9_3/RxD_1$
16	$P9_4/\overline{IRQ_4}/SCK_0$	$P9_4/\overline{IRQ_4}/SCK_0$	$P9_4/\overline{IRQ_4}/SCK_0$	$P9_4/\overline{IRQ_4}/SCK_0$	$P9_4/\overline{IRQ_4}/SCK_0$	$P9_4/\overline{IRQ_4}/SCK_0$
17	$P9_5/\overline{IRQ_5}/SCK_1$	$P9_5/\overline{IRQ_5}/SCK_1$	$P9_5/\overline{IRQ_5}/SCK_1$	$P9_5/\overline{IRQ_5}/SCK_1$	$P9_5/\overline{IRQ_5}/SCK_1$	$P9_5/\overline{IRQ_5}/SCK_1$
18	$P4_0/D_0$*1	$P4_0/D_0$*2	$P4_0/D_0$*1	$P4_0/D_0$*2	$P4_0/D_0$*1	$P4_0$
19	$P4_1/D_1$*1	$P4_1/D_1$*2	$P4_1/D_1$*1	$P4_1/D_1$*2	$P4_1/D_1$*1	$P4_1$
20	$P4_2/D_2$*1	$P4_2/D_2$*2	$P4_2/D_2$*1	$P4_2/D_2$*2	$P4_2/D_2$*1	$P4_2$

Pin No.	Pin Name					
FP-100B TFP-100B	Mode 1	Mode 2	Mode 3	Mode 4	Mode 5	Mode 7
21	$P4_3/D_3$*1	$P4_3/D_3$*2	$P4_3/D_3$*1	$P4_3/D_3$*2	$P4_3/D_3$*1	$P4_3$
22	V_{SS}	V_{SS}	V_{SS}	V_{SS}	V_{SS}	V_{SS}
23	$P4_4/D_4$*1	$P4_4/D_4$*2	$P4_4/D_4$*1	$P4_4/D_4$*2	$P4_4/D_4$*1	$P4_4$
24	$P4_5/D_5$*1	$P4_5/D_5$*2	$P4_5/D_5$*1	$P4_5/D_5$*2	$P4_5/D_5$*1	$P4_5$
25	$P4_6/D_6$*1	$P4_6/D_6$*2	$P4_6/D_6$*1	$P4_6/D_6$*2	$P4_6/D_6$*1	$P4_6$
26	$P4_7/D_7$*1	$P4_7/D_7$*2	$P4_7/D_7$*1	$P4_7/D_7$*2	$P4_7/D_7$*1	$P4_7$
27	D_8	D_8	D_8	D_8	D_8	$P3_0$
28	D_9	D_9	D_9	D_9	D_9	$P3_1$
29	D_{10}	D_{10}	D_{10}	D_{10}	D_{10}	$P3_2$
30	D_{11}	D_{11}	D_{11}	D_{11}	D_{11}	$P3_3$
31	D_{12}	D_{12}	D_{12}	D_{12}	D_{12}	$P3_4$
32	D_{13}	D_{13}	D_{13}	D_{13}	D_{13}	$P3_5$
33	D_{14}	D_{14}	D_{14}	D_{14}	D_{14}	$P3_6$
34	D_{15}	D_{15}	D_{15}	D_{15}	D_{15}	$P3_7$
35	V_{CC}	V_{CC}	V_{CC}	V_{CC}	V_{CC}	V_{CC}
36	A_0	A_0	A_0	A_0	$P1_0/A_0$	$P1_0$
37	A_1	A_1	A_1	A_1	$P1_1/A_1$	$P1_1$
38	A_2	A_2	A_2	A_2	$P1_2/A_2$	$P1_2$
39	A_3	A_3	A_3	A_3	$P1_3/A_3$	$P1_3$
40	A_4	A_4	A_4	A_4	$P1_4/A_4$	$P1_4$
41	A_5	A_5	A_5	A_5	$P1_5/A_5$	$P1_5$
42	A_6	A_6	A_6	A_6	$P1_6/A_6$	$P1_6$
43	A_7	A_7	A_7	A_7	$P1_7/A_7$	$P1_7$
44	V_{SS}	V_{SS}	V_{SS}	V_{SS}	V_{SS}	V_{SS}
45	A_8	A_8	A_8	A_8	$P2_0/A_8$	$P2_0$
46	A_9	A_9	A_9	A_9	$P2_1/A_9$	$P2_1$
47	A_{10}	A_{10}	A_{10}	A_{10}	$P2_2/A_{10}$	$P2_2$
48	A_{11}	A_{11}	A_{11}	A_{11}	$P2_3/A_{11}$	$P2_3$
49	A_{12}	A_{12}	A_{12}	A_{12}	$P2_4/A_{12}$	$P2_4$
50	A_{13}	A_{13}	A_{13}	A_{13}	$P2_5/A_{13}$	$P2_5$
51	A_{14}	A_{14}	A_{14}	A_{14}	$P2_6/A_{14}$	$P2_6$
52	A_{15}	A_{15}	A_{15}	A_{15}	$P2_7/A_{15}$	$P2_7$
53	A_{16}	A_{16}	A_{16}	A_{16}	$P5_0/A_{16}$	$P5_0$
54	A_{17}	A_{17}	A_{17}	A_{17}	$P5_1/A_{17}$	$P5_1$

Pin No.	Pin Name					
FP-100B TFP-100B	Mode 1	Mode 2	Mode 3	Mode 4	Mode 5	Mode 7
55	A_{18}	A_{18}	A_{18}	A_{18}	$P5_2/A_{18}$	$P5_2$
56	A_{19}	A_{19}	A_{19}	A_{19}	$P5_3/A_{19}$	$P5_3$
57	V_{SS}	V_{SS}	V_{SS}	V_{SS}	V_{SS}	V_{SS}
58	$P6_0/\overline{WAIT}$	$P6_0/\overline{WAIT}$	$P6_0/\overline{WAIT}$	$P6_0/\overline{WAIT}$	$P6_0/\overline{WAIT}$	$P6_0$
59	$P6_1/\overline{BREQ}$	$P6_1/\overline{BREQ}$	$P6_1/\overline{BREQ}$	$P6_1/\overline{BREQ}$	$P6_1/\overline{BREQ}$	$P6_1$
60	$P6_2/\overline{BACK}$	$P6_2/\overline{BACK}$	$P6_2/\overline{BACK}$	$P6_2/\overline{BACK}$	$P6_2/\overline{BACK}$	$P6_2$
61	$P6_7/\phi$*3	$P6_7/\phi$*3	$P6_7/\phi$*3	$P6_7/\phi$*3	$P6_7/\phi$*3	$P6_7/\phi$*4
62	$\overline{STBY}$	$\overline{STBY}$	$\overline{STBY}$	$\overline{STBY}$	$\overline{STBY}$	$\overline{STBY}$
63	$\overline{RES}$	$\overline{RES}$	$\overline{RES}$	$\overline{RES}$	$\overline{RES}$	$\overline{RES}$
64	NMI	NMI	NMI	NMI	NMI	NMI
65	V_{SS}	V_{SS}	V_{SS}	V_{SS}	V_{SS}	V_{SS}
66	EXTAL	EXTAL	EXTAL	EXTAL	EXTAL	EXTAL
67	XTAL	XTAL	XTAL	XTAL	XTAL	XTAL
68	V_{CC}	V_{CC}	V_{CC}	V_{CC}	V_{CC}	V_{CC}
69	$\overline{AS}$	$\overline{AS}$	$\overline{AS}$	$\overline{AS}$	$\overline{AS}$	$P6_3$
70	$\overline{RD}$	$\overline{RD}$	$\overline{RD}$	$\overline{RD}$	$\overline{RD}$	$P6_4$
71	$\overline{HWR}$	$\overline{HWR}$	$\overline{HWR}$	$\overline{HWR}$	$\overline{HWR}$	$P6_5$
72	$\overline{LWR}$	$\overline{LWR}$	$\overline{LWR}$	$\overline{LWR}$	$\overline{LWR}$	$P6_6$
73	MD_0	MD_0	MD_0	MD_0	MD_0	MD_0
74	MD_1	MD_1	MD_1	MD_1	MD_1	MD_1
75	MD_2	MD_2	MD_2	MD_2	MD_2	MD_2
76	AV_{CC}	AV_{CC}	AV_{CC}	AV_{CC}	AV_{CC}	AV_{CC}
77	V_{REF}	V_{REF}	V_{REF}	V_{REF}	V_{REF}	V_{REF}
78	$P7_0/AN_0$	$P7_0/AN_0$	$P7_0/AN_0$	$P7_0/AN_0$	$P7_0/AN_0$	$P7_0/AN_0$
79	$P7_1/AN_1$	$P7_1/AN_1$	$P7_1/AN_1$	$P7_1/AN_1$	$P7_1/AN_1$	$P7_1/AN_1$
80	$P7_2/AN_2$	$P7_2/AN_2$	$P7_2/AN_2$	$P7_2/AN_2$	$P7_2/AN_2$	$P7_2/AN_2$
81	$P7_3/AN_3$	$P7_3/AN_3$	$P7_3/AN_3$	$P7_3/AN_3$	$P7_3/AN_3$	$P7_3/AN_3$
82	$P7_4/AN_4$	$P7_4/AN_4$	$P7_4/AN_4$	$P7_4/AN_4$	$P7_4/AN_4$	$P7_4/AN_4$
83	$P7_5/AN_5$	$P7_5/AN_5$	$P7_5/AN_5$	$P7_5/AN_5$	$P7_5/AN_5$	$P7_5/AN_5$
84	$P7_6/AN_6$/ DA_0	$P7_6/AN_6$/ DA_0	$P7_6/AN_6$/ DA_0	$P7_6/AN_6$/ DA_0	$P7_6/AN_6$/ DA_0	$P7_6/AN_6$/ DA_0
85	$P7_7/AN_7$/ DA_1	$P7_7/AN_7$/ DA_1	$P7_7/AN_7$/ DA_1	$P7_7/AN_7$/ DA_1	$P7_7/AN_7$/ DA_1	$P7_7/AN_7$/ DA_1
86	AV_{SS}	AV_{SS}	AV_{SS}	AV_{SS}	AV_{SS}	AV_{SS}

Pin No.	Pin Name					
FP-100B TFP-100B	Mode 1	Mode 2	Mode 3	Mode 4	Mode 5	Mode 7
87	$P8_0/\overline{IRQ_0}/\overline{RFSH}$	$P8_0/\overline{IRQ_0}/\overline{RFSH}$	$P8_0/\overline{IRQ_0}/\overline{RFSH}$	$P8_0/\overline{IRQ_0}/\overline{RFSH}$	$P8_0/\overline{IRQ_0}/\overline{RFSH}$	$P8_0/\overline{IRQ_0}$
88	$P8_1/\overline{IRQ_1}/\overline{CS_3}$	$P8_1/\overline{IRQ_1}/\overline{CS_3}$	$P8_1/\overline{IRQ_1}/\overline{CS_3}$	$P8_1/\overline{IRQ_1}/\overline{CS_3}$	$P8_1/\overline{IRQ_1}/\overline{CS_3}$	$P8_1/\overline{IRQ_1}$
89	$P8_2/\overline{IRQ_2}/\overline{CS_2}$	$P8_2/\overline{IRQ_2}/\overline{CS_2}$	$P8_2/\overline{IRQ_2}/\overline{CS_2}$	$P8_2/\overline{IRQ_2}/\overline{CS_2}$	$P8_2/\overline{IRQ_2}/\overline{CS_2}$	$P8_2/\overline{IRQ_2}$
90	$P8_3/\overline{IRQ_3}/\overline{CS_1}/\overline{ADTRG}$	$P8_3/\overline{IRQ_3}/\overline{CS_1}/\overline{ADTRG}$	$P8_3/\overline{IRQ_3}/\overline{CS_1}/\overline{ADTRG}$	$P8_3/\overline{IRQ_3}/\overline{CS_1}/\overline{ADTRG}$	$P8_3/\overline{IRQ_3}/\overline{CS_1}/\overline{ADTRG}$	$P8_3/\overline{IRQ_3}/\overline{ADTRG}$
91	$P8_4/\overline{CS_0}$	$P8_4/\overline{CS_0}$	$P8_4/\overline{CS_0}$	$P8_4/\overline{CS_0}$	$P8_4/\overline{CS_0}$	$P8_4$
92	V_{SS}	V_{SS}	V_{SS}	V_{SS}	V_{SS}	V_{SS}
93	$PA_0/TP_0/TCLKA/\overline{TEND_0}$	$PA_0/TP_0/TCLKA/\overline{TEND_0}$	$PA_0/TP_0/TCLKA/\overline{TEND_0}$	$PA_0/TP_0/TCLKA/\overline{TEND_0}$	$PA_0/TP_0/TCLKA/\overline{TEND_0}$	$PA_0/TP_0/TCLKA/\overline{TEND_0}$
94	$PA_1/TP_1/TCLKB/\overline{TEND_1}$	$PA_1/TP_1/TCLKB/\overline{TEND_1}$	$PA_1/TP_1/TCLKB/\overline{TEND_1}$	$PA_1/TP_1/TCLKB/\overline{TEND_1}$	$PA_1/TP_1/TCLKB/\overline{TEND_1}$	$PA_1/TP_1/TCLKB/\overline{TEND_1}$
95	$PA_2/TP_2/TIOCA_0/TCLKC$	$PA_2/TP_2/TIOCA_0/TCLKC$	$PA_2/TP_2/TIOCA_0/TCLKC$	$PA_2/TP_2/TIOCA_0/TCLKC$	$PA_2/TP_2/TIOCA_0/TCLKC$	$PA_2/TP_2/TIOCA_0/TCLKC$
96	$PA_3/TP_3/TIOCB_0/TCLKD$	$PA_3/TP_3/TIOCB_0/TCLKD$	$PA_3/TP_3/TIOCB_0/TCLKD$	$PA_3/TP_3/TIOCB_0/TCLKD$	$PA_3/TP_3/TIOCB_0/TCLKD$	$PA_3/TP_3/TIOCB_0/TCLKD$
97	$PA_4/TP_4/TIOCA_1$	$PA_4/TP_4/TIOCA_1$	$PA_4/TP_4/TIOCA_1/A_{23}$	$PA_4/TP_4/TIOCA_1/A_{23}$	$PA_4/TP_4/TIOCA_1/A_{23}$	$PA_4/TP_4/TIOCA_1$
98	$PA_5/TP_5/TIOCB_1$	$PA_5/TP_5/TIOCB_1$	$PA_5/TP_5/TIOCB_1/A_{22}$	$PA_5/TP_5/TIOCB_1/A_{22}$	$PA_5/TP_5/TIOCB_1/A_{22}$	$PA_5/TP_5/TIOCB_1$
99	$PA_6/TP_6/TIOCA_2$	$PA_6/TP_6/TIOCA_2$	$PA_6/TP_6/TIOCA_2/A_{21}$	$PA_6/TP_6/TIOCA_2/A_{21}$	$PA_6/TP_6/TIOCA_2/A_{21}$	$PA_6/TP_6/TIOCA_2$
100	$PA_7/TP_7/TIOCB_2$	$PA_7/TP_7/TIOCB_2$	A_{20}	A_{20}	$PA_7/TP_7/TIOCB_2/A_{20}$	$PA_7/TP_7/TIOCB_2$

Notes:
1. In modes 1, 3, 5 the $P4_0$ to $P4_7$ functions of pins $P4_0/D_0$ to $P4_7/D_7$ are selected after a reset, but they can be changed by software.
2. In modes 2 and 4 the D_0 to D_7 functions of pins $P4_0/D_0$ to $P4_7/D_7$ are selected after a reset, but they can be changed by software.
3. In modes 1 to 5 the $P6_7/\phi$ pin is the ϕ pin after a reset, but it can be changed by software.
4. In mode 7 the $P6_7/\phi$ pin is set as the $P6_7$ pin after a reset, but it can be changed by software.

Section 2 CPU

2.1 Overview

The H8/300H CPU is a high-speed central processing unit with an internal 32-bit architecture that is upward-compatible with the H8/300 CPU. The H8/300H CPU has sixteen 16-bit general registers, can address a 16-Mbyte linear address space, and is ideal for realtime control.

2.1.1 Features

The H8/300H CPU has the following features.

- Upward compatibility with H8/300 CPU
  Can execute H8/300 Series object programs
- General-register architecture
  Sixteen 16-bit general registers (also usable as sixteen 8-bit registers or eight 32-bit registers)
- Sixty-two basic instructions
  - 8/16/32-bit arithmetic and logic instructions
  - Multiply and divide instructions
  - Powerful bit-manipulation instructions
- Eight addressing modes
  - Register direct [Rn]
  - Register indirect [@ERn]
  - Register indirect with displacement [@(d:16, ERn) or @(d:24, ERn)]
  - Register indirect with post-increment or pre-decrement [@ERn+ or @–ERn]
  - Absolute address [@aa:8, @aa:16, or @aa:24]
  - Immediate [#xx:8, #xx:16, or #xx:32]
  - Program-counter relative [@(d:8, PC) or @(d:16, PC)]
  - Memory indirect [@@aa:8]
- 16-Mbyte linear address space

- High-speed operation
  - All frequently-used instructions execute in two to four states
  - Maximum clock frequency :25 MHz
  - 8/16/32-bit register-register add/subtract :80 ns
  - 8 × 8-bit register-register multiply :560 ns
  - 16 ÷ 8-bit register-register divide :560 ns
  - 16 × 16-bit register-register multiply :880 ns
  - 32 ÷ 16-bit register-register divide :880 ns
- Two CPU operating modes
  - Normal mode
  - Advanced mode
- Low-power mode

  Transition to power-down state by SLEEP instruction

2.1.2 Differences from H8/300 CPU

In comparison to the H8/300 CPU, the H8/300H has the following enhancements.

- More general registers

  Eight 16-bit registers have been added.
- Expanded address space
  - Advanced mode supports a maximum 16-Mbyte address space.
  - Normal mode supports the same 64-kbyte address space as the H8/300 CPU. (Normal mode cannot be selected in the H8/3069R.)
- Enhanced addressing

  The addressing modes have been enhanced to make effective use of the 16-Mbyte address space.
- Enhanced instructions
  - Data transfer, arithmetic, and logic instructions can operate on 32-bit data.
  - Signed multiply/divide instructions and other instructions have been added.

2.2 CPU Operating Modes

The H8/300H CPU has two operating modes: normal and advanced. Normal mode supports a maximum 64-kbyte address space. Advanced mode supports up to 16 Mbytes.

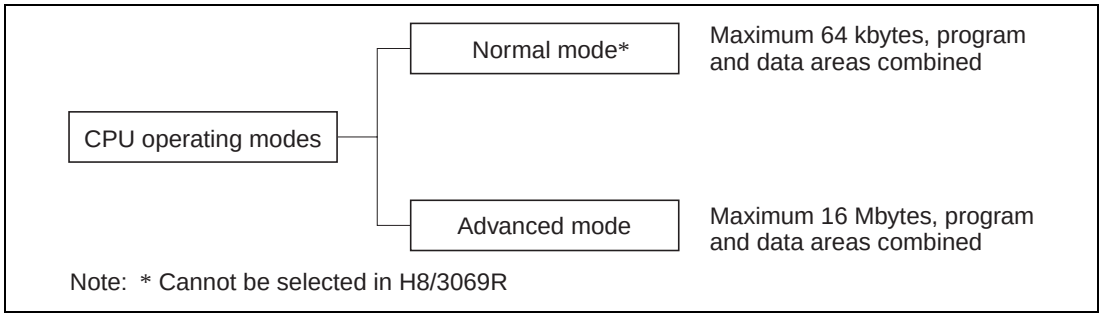


Figure 2.1 CPU Operating Modes

2.3 Address Space

Figure 2.2 shows a simple memory map for the H8/3069R. The H8/300H CPU can address a linear address space with a maximum size of 64 kbytes in normal mode, and 16 Mbytes in advanced mode. For further details see section 3.6, Memory Map in Each Operating Mode.

The 1-Mbyte operating modes use 20-bit addressing. The upper 4 bits of effective addresses are ignored.

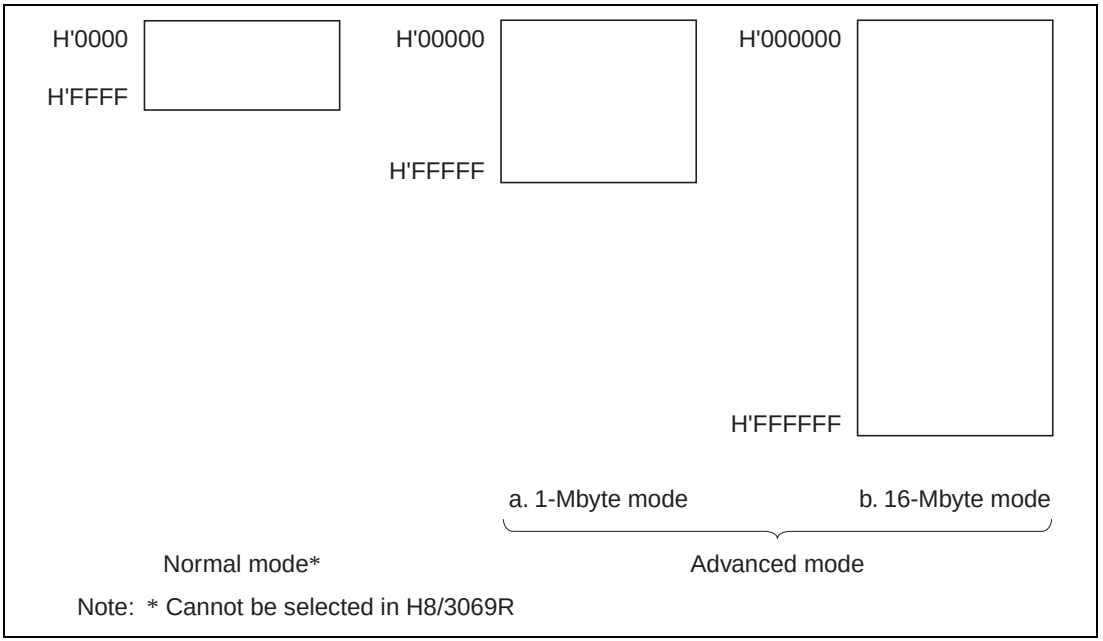


Figure 2.2 Memory Map

2.4 Register Configuration

2.4.1 Overview

The H8/300H CPU has the internal registers shown in figure 2.3. There are two types of registers: general registers and control registers.

General Registers (ERn)

	15 — 0	7 — 0	7 — 0
ER0	E0	R0H	R0L
ER1	E1	R1H	R1L
ER2	E2	R2H	R2L
ER3	E3	R3H	R3L
ER4	E4	R4H	R4L
ER5	E5	R5H	R5L
ER6	E6	R6H	R6L
ER7	E7	(SP) R7H	R7L

Control Registers (CR)

	23 — 0
PC	

	7	6	5	4	3	2	1	0
CCR	I	UI	H	U	N	Z	V	C

[Legend]
SP: Stack pointer
PC: Program counter
CCR: Condition code register
I: Interrupt mask bit
UI: User bit or interrupt mask bit
H: Half-carry flag
U: User bit
N: Negative flag
Z: Zero flag
V: Overflow flag
C: Carry flag

Figure 2.3 CPU Registers

2.4.2 General Registers

The H8/300H CPU has eight 32-bit general registers. These general registers are all functionally alike and can be used without distinction between data registers and address registers. When a general register is used as a data register, it can be accessed as a 32-bit, 16-bit, or 8-bit register. When the general registers are used as 32-bit registers or as address registers, they are designated by the letters ER (ER0 to ER7).

The ER registers divide into 16-bit general registers designated by the letters E (E0 to E7) and R (R0 to R7). These registers are functionally equivalent, providing a maximum sixteen 16-bit registers. The E registers (E0 to E7) are also referred to as extended registers.

The R registers divide into 8-bit general registers designated by the letters RH (R0H to R7H) and RL (R0L to R7L). These registers are functionally equivalent, providing a maximum sixteen 8-bit registers.

Figure 2.4 illustrates the usage of the general registers. The usage of each register can be selected independently.

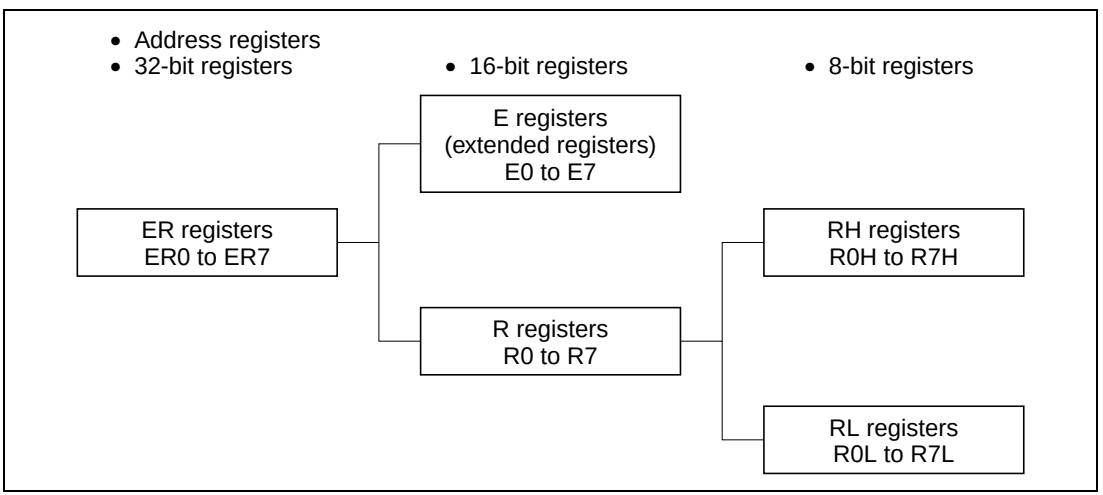


Figure 2.4 Usage of General Registers

General register ER7 has the function of stack pointer (SP) in addition to its general-register function, and is used implicitly in exception handling and subroutine calls. Figure 2.5 shows the stack.

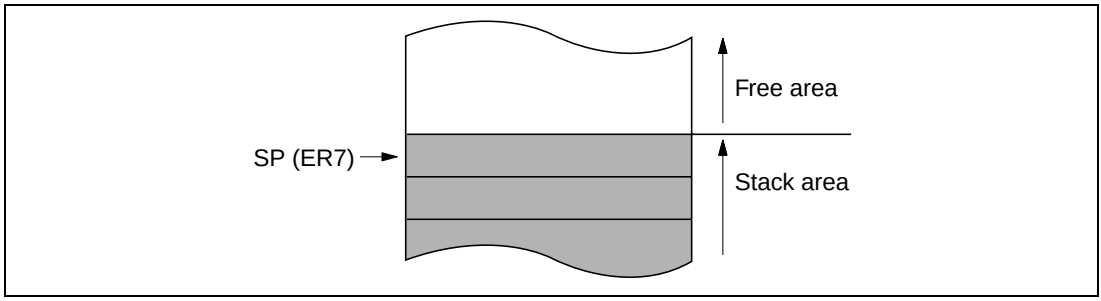


Figure 2.5 Stack

2.4.3 Control Registers

The control registers are the 24-bit program counter (PC) and the 8-bit condition code register (CCR).

Program Counter (PC): This 24-bit counter indicates the address of the next instruction the CPU will execute. The length of all CPU instructions is 2 bytes (one word), so the least significant PC bit is ignored. When an instruction is fetched, the least significant PC bit is regarded as 0.

Condition Code Register (CCR): This 8-bit register contains internal CPU status information, including the interrupt mask bit (I) and half-carry (H), negative (N), zero (Z), overflow (V), and carry (C) flags.

Bit 7—Interrupt Mask Bit (I): Masks interrupts other than NMI when set to 1. NMI is accepted regardless of the I bit setting. The I bit is set to 1 at the start of an exception-handling sequence.

Bit 6—User Bit or Interrupt Mask Bit (UI): Can be written and read by software using the LDC, STC, ANDC, ORC, and XORC instructions. This bit can also be used as an interrupt mask bit. For details see section 5, Interrupt Controller.

Bit 5—Half-Carry Flag (H): When the ADD.B, ADDX.B, SUB.B, SUBX.B, CMP.B, or NEG.B instruction is executed, this flag is set to 1 if there is a carry or borrow at bit 3, and cleared to 0 otherwise. When the ADD.W, SUB.W, CMP.W, or NEG.W instruction is executed, the H flag is set to 1 if there is a carry or borrow at bit 11, and cleared to 0 otherwise. When the ADD.L, SUB.L, CMP.L, or NEG.L instruction is executed, the H flag is set to 1 if there is a carry or borrow at bit 27, and cleared to 0 otherwise.

Bit 4—User Bit (U): Can be written and read by software using the LDC, STC, ANDC, ORC, and XORC instructions.

Bit 3—Negative Flag (N): Stores the value of the most significant bit of data, regarded as the sign bit.

Bit 2—Zero Flag (Z): Set to 1 to indicate zero data, and cleared to 0 to indicate non-zero data.

Bit 1—Overflow Flag (V): Set to 1 when an arithmetic overflow occurs, and cleared to 0 at other times.

Bit 0—Carry Flag (C): Set to 1 when a carry is generated by execution of an operation, and cleared to 0 otherwise. Used by:

- Add instructions, to indicate a carry
- Subtract instructions, to indicate a borrow
- Shift and rotate instructions

The carry flag is also used as a bit accumulator by bit manipulation instructions.

Some instructions leave flag bits unchanged. Operations can be performed on CCR by the LDC, STC, ANDC, ORC, and XORC instructions. The N, Z, V, and C flags are used by conditional branch (Bcc) instructions.

For the action of each instruction on the flag bits, see appendix A.1, Instruction List. For the I and UI bits, see section 5, Interrupt Controller.

2.4.4 Initial CPU Register Values

In reset exception handling, PC is initialized to a value loaded from the vector table, and the I bit in CCR is set to 1. The other CCR bits and the general registers are not initialized. In particular, the initial value of the stack pointer (ER7) is also undefined. The stack pointer (ER7) must therefore be initialized by an MOV.L instruction executed immediately after a reset.

2.5 Data Formats

The H8/300H CPU can process 1-bit, 4-bit (BCD), 8-bit (byte), 16-bit (word), and 32-bit (longword) data. Bit-manipulation instructions operate on 1-bit data by accessing bit n (n = 0, 1, 2, …, 7) of byte operand data. The DAA and DAS decimal-adjust instructions treat byte data as two digits of 4-bit BCD data.

2.5.1 General Register Data Formats

Figures 2.6 and 2.7 show the data formats in general registers.

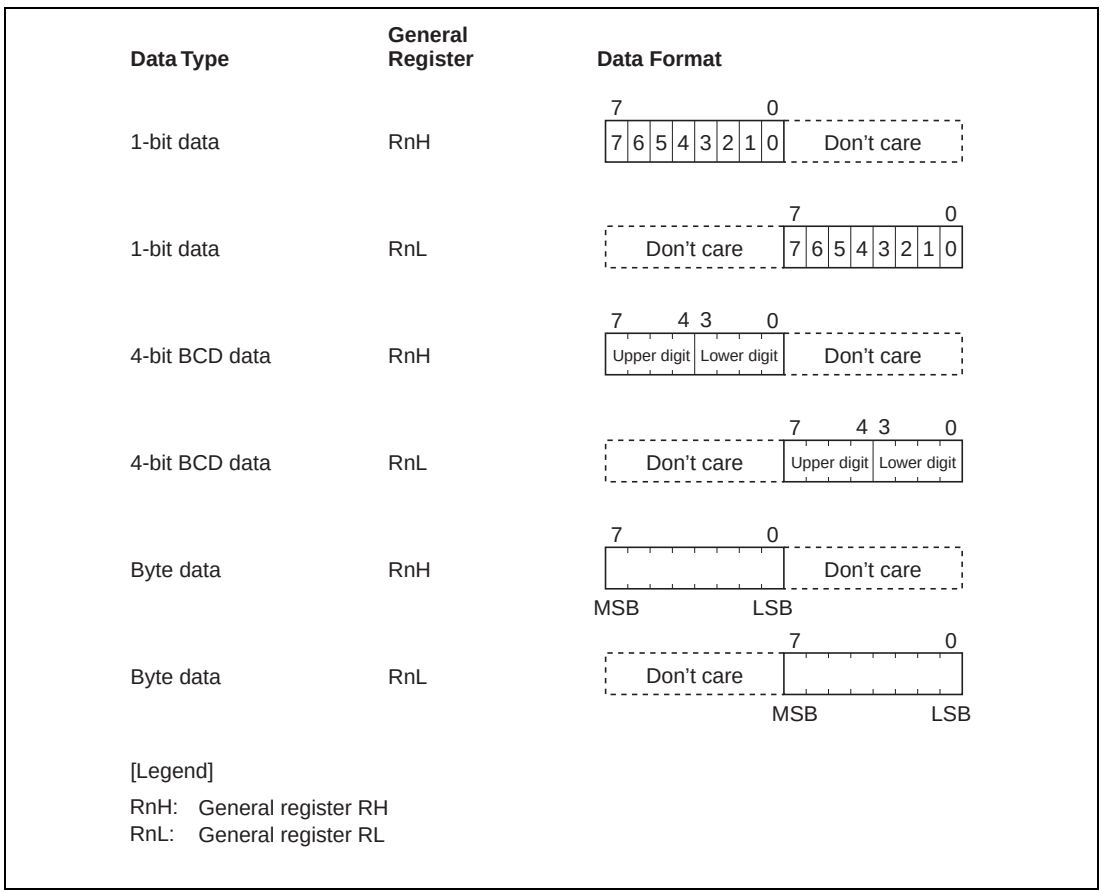


Figure 2.6 General Register Data Formats

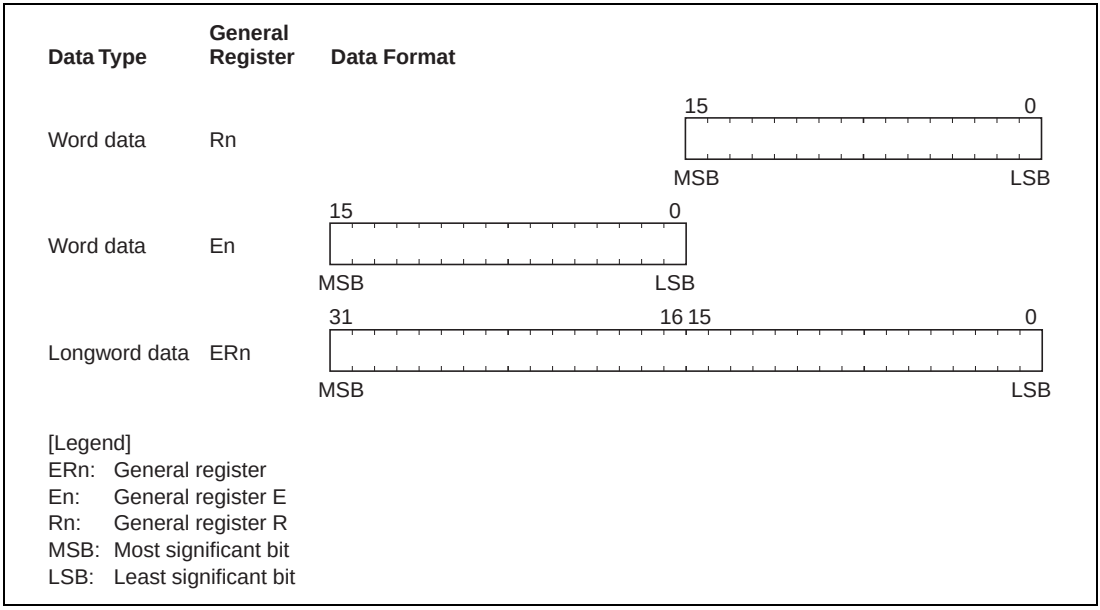


Figure 2.7 General Register Data Formats

2.5.2 Memory Data Formats

Figure 2.8 shows the data formats on memory. The H8/300H CPU can access word data and longword data on memory, but word or longword data must begin at an even address. If an attempt is made to access word or longword data at an odd address, no address error occurs but the least significant bit of the address is regarded as 0, so the access starts at the preceding address. This also applies to instruction fetches.

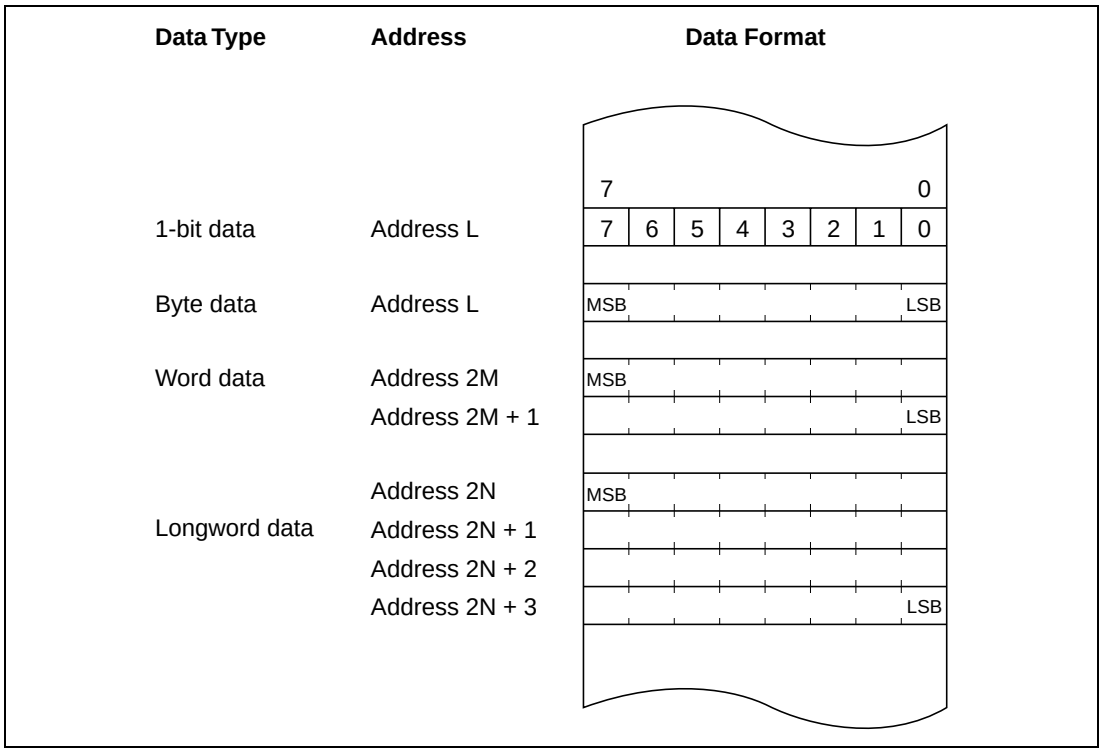


Figure 2.8 Memory Data Formats

When ER7 (SP) is used as an address register to access the stack, the operand size should be word size or longword size.

2.6 Instruction Set

2.6.1 Instruction Set Overview

The H8/300H CPU has 62 types of instructions, which are classified in table 2.1.

Table 2.1 Instruction Classification

Function	Instruction	Types
Data transfer	MOV, PUSH*[1], POP*[1], MOVTPE*[2], MOVFPE*[2]	3
Arithmetic operations	ADD, SUB, ADDX, SUBX, INC, DEC, ADDS, SUBS, DAA, DAS, MULXU, MULXS, DIVXU, DIVXS, CMP, NEG, EXTS, EXTU	18
Logic operations	AND, OR, XOR, NOT	4
Shift operations	SHAL, SHAR, SHLL, SHLR, ROTL, ROTR, ROTXL, ROTXR	8
Bit manipulation	BSET, BCLR, BNOT, BTST, BAND, BIAND, BOR, BIOR, BXOR, BIXOR, BLD, BILD, BST, BIST	14
Branch	Bcc*[3], JMP, BSR, JSR, RTS	5
System control	TRAPA, RTE, SLEEP, LDC, STC, ANDC, ORC, XORC, NOP	9
Block data transfer	EEPMOV	1
		Total 62 types

Notes: 1. POP.W Rn is identical to MOV.W @SP+, Rn.
PUSH.W Rn is identical to MOV.W Rn, @–SP.
POP.L ERn is identical to MOV.L @SP+, Rn.
PUSH.L ERn is identical to MOV.L Rn, @–SP.
2. Not available in the H8/3069R.
3. Bcc is a generic branching instruction.

2.6.2 Instructions and Addressing Modes

Table 2.2 indicates the instructions available in the H8/300H CPU.

Table 2.2 Instructions and Addressing Modes

		Addressing Modes												
Function	**Instruction**	**#xx**	**Rn**	**@ERn**	**@ (d:16, ERn)**	**@ (d:24, ERn)**	**@ERn+/ @–ERn**	**@ aa:8**	**@ aa:16**	**@ aa:24**	**@ (d:8, PC)**	**@ (d:16, PC)**	**@@ aa:8**	**—**
Data transfer	MOV	BWL	BWL	BWL	BWL	BWL	BWL	B	BWL	BWL	—	—	—	—
	POP, PUSH	—	—	—	—	—	—	—	—	—	—	—	—	WL
	MOVFPE, MOVTPE	—	—	—	—	—	—	—	—	—	—	—	—	—
Arithmetic operations	ADD, CMP	BWL	BWL	—	—	—	—	—	—	—	—	—	—	—
	SUB	WL	BWL	—	—	—	—	—	—	—	—	—	—	—
	ADDX, SUBX	B	B	—	—	—	—	—	—	—	—	—	—	—
	ADDS, SUBS	—	L	—	—	—	—	—	—	—	—	—	—	—
	INC, DEC	—	BWL	—	—	—	—	—	—	—	—	—	—	—
	DAA, DAS	—	B	—	—	—	—	—	—	—	—	—	—	—
	MULXU, MULXS, DIVXU, DIVXS	—	BW	—	—	—	—	—	—	—	—	—	—	—
	NEG	—	BWL	—	—	—	—	—	—	—	—	—	—	—
	EXTU, EXTS	—	WL	—	—	—	—	—	—	—	—	—	—	—
Logic operations	AND, OR, XOR	—	BWL	—	—	—	—	—	—	—	—	—	—	—
	NOT	—	BWL	—	—	—	—	—	—	—	—	—	—	—
Shift instructions		—	BWL	—	—	—	—	—	—	—	—	—	—	—
Bit manipulation		—	B	B	—	—	—	B	—	—	—	—	—	—
Branch	Bcc, BSR	—	—	—	—	—	—	—	—	—	—	—	—	—
	JMP, JSR	—	—	○	—	—	—	—	—	—	○	○	—	—
	RTS	—	—	—	—	—	—	—	—	○	—	—	○	—
System control	TRAPA	—	—	—	—	—	—	—	—	—	—	—	—	○
	RTE	—	—	—	—	—	—	—	—	—	—	—	—	○
	SLEEP	—	—	—	—	—	—	—	—	—	—	—	—	○
	LDC	B	B	W	W	W	W	—	W	W	—	—	—	○
	STC	—	B	W	W	W	W	—	W	W	—	—	—	—
	ANDC, ORC, XORC	B	—	—	—	—	—	—	—	—	—	—	—	—
	NOP	—	—	—	—	—	—	—	—	—	—	—	—	○
Block data transfer		—	—	—	—	—	—	—	—	—	—	—	—	BW

2.6.3 Tables of Instructions Classified by Function

Tables 2.3 to 2.10 summarize the instructions in each functional category. The operation notation used in these tables is defined next.

Operation Notation

Rd	General register (destination)*
Rs	General register (source)*
Rn	General register*
ERn	General register (32-bit register or address register)
(EAd)	Destination operand
(EAs)	Source operand
CCR	Condition code register
N	N (negative) flag of CCR
Z	Z (zero) flag of CCR
V	V (overflow) flag of CCR
C	C (carry) flag of CCR
PC	Program counter
SP	Stack pointer
#IMM	Immediate data
disp	Displacement
+	Addition
–	Subtraction
×	Multiplication
÷	Division
∧	AND logical
∨	OR logical
⊕	Exclusive OR logical
→	Move
¬	NOT (logical complement)
:3/:8/:16/:24	3-, 8-, 16-, or 24-bit length

Note: * General registers include 8-bit registers (R0H to R7H, R0L to R7L), 16-bit registers (R0 to R7, E0 to E7), and 32-bit data or address registers (ER0 to ER7).

Table 2.3 Data Transfer Instructions

Instruction	Size*	Function
MOV	B/W/L	(EAs) → Rd, Rs → (EAd) Moves data between two general registers or between a general register and memory, or moves immediate data to a general register.
MOVFPE	B	(EAs) → Rd Cannot be used in this LSI.
MOVTPE	B	Rs → (EAs) Cannot be used in this LSI.
POP	W/L	@SP+ → Rn Pops a general register from the stack. POP.W Rn is identical to MOV.W @SP+, Rn. Similarly, POP.L ERn is identical to MOV.L @SP+, ERn.
PUSH	W/L	Rn → @–SP Pushes a general register onto the stack. PUSH.W Rn is identical to MOV.W Rn, @–SP. Similarly, PUSH.L ERn is identical to MOV.L ERn, @–SP.

Note: * Size refers to the operand size.
B: Byte
W: Word
L: Longword

Table 2.4 Arithmetic Operation Instructions

Instruction	Size*	Function
ADD,SUB	B/W/L	Rd ± Rs → Rd, Rd ± #IMM → Rd Performs addition or subtraction on data in two general registers, or on immediate data and data in a general register. (Immediate byte data cannot be subtracted from data in a general register. Use the SUBX or ADD instruction.)
ADDX, SUBX	B	Rd ± Rs ± C → Rd, Rd ± #IMM ± C → Rd Performs addition or subtraction with carry or borrow on data in two general registers, or on immediate data and data in a general register.
INC, DEC	B/W/L	Rd ± 1 → Rd, Rd ± 2 → Rd Increments or decrements a general register by 1 or 2. (Byte operands can be incremented or decremented by 1 only.)
ADDS, SUBS	L	Rd ± 1 → Rd, Rd ± 2 → Rd, Rd ± 4 → Rd Adds or subtracts the value 1, 2, or 4 to or from data in a 32-bit register.
DAA, DAS	B	Rd decimal adjust → Rd Decimal-adjusts an addition or subtraction result in a general register by referring to CCR to produce 4-bit BCD data.
MULXU	B/W	Rd × Rs → Rd Performs unsigned multiplication on data in two general registers: either 8 bits × 8 bits → 16 bits or 16 bits × 16 bits → 32 bits.
MULXS	B/W	Rd × Rs → Rd Performs signed multiplication on data in two general registers: either 8 bits × 8 bits → 16 bits or 16 bits × 16 bits → 32 bits.
DIVXU	B/W	Rd ÷ Rs → Rd Performs unsigned division on data in two general registers: either 16 bits ÷ 8 bits → 8-bit quotient and 8-bit remainder or 32 bits ÷ 16 bits → 16-bit quotient and 16-bit remainder
DIVXS	B/W	Rd ÷ Rs → Rd Performs signed division on data in two general registers: either 16 bits ÷ 8 bits → 8-bit quotient and 8-bit remainder, or 32 bits ÷ 16 bits → 16-bit quotient and 16-bit remainder
CMP	B/W/L	Rd – Rs, Rd – #IMM Compares data in a general register with data in another general register or with immediate data, and sets CCR according to the result.
NEG	B/W/L	0 – Rd → Rd Takes the two's complement (arithmetic complement) of data in a general register.

Instruction	Size*	Function
EXTS	W/L	Rd (sign extension) → Rd Extends byte data in the lower 8 bits of a 16-bit register to word data, or extends word data in the lower 16 bits of a 32-bit register to longword data, by extending the sign bit.
EXTU	W/L	Rd (zero extension) → Rd Extends byte data in the lower 8 bits of a 16-bit register to word data, or extends word data in the lower 16 bits of a 32-bit register to longword data, by padding with zeros.

Note: * Size refers to the operand size.
B: Byte
W: Word
L: Longword

Table 2.5 Logic Operation Instructions

Instruction	Size*	Function
AND	B/W/L	Rd ∧ Rs → Rd, Rd ∧ #IMM → Rd Performs a logical AND operation on a general register and another general register or immediate data.
OR	B/W/L	Rd ∨ Rs → Rd, Rd ∨ #IMM → Rd Performs a logical OR operation on a general register and another general register or immediate data.
XOR	B/W/L	Rd ⊕ Rs → Rd, Rd ⊕ #IMM → Rd Performs a logical exclusive OR operation on a general register and another general register or immediate data.
NOT	B/W/L	¬ Rd → Rd Takes the one's complement (logical complement) of general register contents.

Note: * Size refers to the operand size.
B: Byte
W: Word
L: Longword

Table 2.6 Shift Instructions

Instruction	Size*	Function
SHAL, SHAR	B/W/L	Rd (shift) → Rd Performs an arithmetic shift on general register contents.
SHLL, SHLR	B/W/L	Rd (shift) → Rd Performs a logical shift on general register contents.
ROTL, ROTR	B/W/L	Rd (rotate) → Rd Rotates general register contents.
ROTXL, ROTXR	B/W/L	Rd (rotate) → Rd Rotates general register contents, including the carry bit.

Note: * Size refers to the operand size.
B: Byte
W: Word
L: Longword

Table 2.7 Bit Manipulation Instructions

Instruction	Size*	Function
BSET	B	1 → (<bit-No.> of <EAd>) Sets a specified bit in a general register or memory operand to 1. The bit number is specified by 3-bit immediate data or the lower 3 bits of a general register.
BCLR	B	0 → (<bit-No.> of <EAd>) Clears a specified bit in a general register or memory operand to 0. The bit number is specified by 3-bit immediate data or the lower 3 bits of a general register.
BNOT	B	¬ (<bit-No.> of <EAd>) → (<bit-No.> of <EAd>) Inverts a specified bit in a general register or memory operand. The bit number is specified by 3-bit immediate data or the lower 3 bits of a general register.
BTST	B	¬ (<bit-No.> of <EAd>) → Z Tests a specified bit in a general register or memory operand and sets or clears the Z flag accordingly. The bit number is specified by 3-bit immediate data or the lower 3 bits of a general register.
BAND	B	C ∧ (<bit-No.> of <EAd>) → C ANDs the carry flag with a specified bit in a general register or memory operand and stores the result in the carry flag.
BIAND	B	C ∧ [¬ (<bit-No.> of <EAd>)] → C ANDs the carry flag with the inverse of a specified bit in a general register or memory operand and stores the result in the carry flag. The bit number is specified by 3-bit immediate data.
BOR	B	C ∨ (<bit-No.> of <EAd>) → C ORs the carry flag with a specified bit in a general register or memory operand and stores the result in the carry flag.
BIOR	B	C ∨ [¬ (<bit-No.> of <EAd>)] → C ORs the carry flag with the inverse of a specified bit in a general register or memory operand and stores the result in the carry flag. The bit number is specified by 3-bit immediate data.
BXOR	B	C ⊕ (<bit-No.> of <EAd>) → C Exclusive-ORs the carry flag with a specified bit in a general register or memory operand and stores the result in the carry flag.
BIXOR	B	C ⊕ [¬ (<bit-No.> of <EAd>)] → C Exclusive-ORs the carry flag with the inverse of a specified bit in a general register or memory operand and stores the result in the carry flag. The bit number is specified by 3-bit immediate data.

Instruction	Size*	Function
BLD	B	(<bit-No.> of <EAd>) → C Transfers a specified bit in a general register or memory operand to the carry flag.
BILD	B	¬ (<bit-No.> of <EAd>) → C Transfers the inverse of a specified bit in a general register or memory operand to the carry flag. The bit number is specified by 3-bit immediate data.
BST	B	C → (<bit-No.> of <EAd>) Transfers the carry flag value to a specified bit in a general register or memory operand.
BIST	B	C → ¬ (<bit-No.> of <EAd>) Transfers the inverse of the carry flag value to a specified bit in a general register or memory operand. The bit number is specified by 3-bit immediate data.

Note: * Size refers to the operand size.
B: Byte

Table 2.8 Branching Instructions

Instruction	Size	Function		
Bcc	—	Branches to a specified address if address specified condition is met. The branching conditions are listed below.		
		Mnemonic	**Description**	**Condition**
		BRA (BT)	Always (true)	Always
		BRN (BF)	Never (false)	Never
		BHI	High	$C \vee Z = 0$
		BLS	Low or same	$C \vee Z = 1$
		Bcc (BHS)	Carry clear (high or same)	$C = 0$
		BCS (BLO)	Carry set (low)	$C = 1$
		BNE	Not equal	$Z = 0$
		BEQ	Equal	$Z = 1$
		BVC	Overflow clear	$V = 0$
		BVS	Overflow set	$V = 1$
		BPL	Plus	$N = 0$
		BMI	Minus	$N = 1$
		BGE	Greater or equal	$N \oplus V = 0$
		BLT	Less than	$N \oplus V = 1$
		BGT	Greater than	$Z \vee (N \oplus V) = 0$
		BLE	Less or equal	$Z \vee (N \oplus V) = 1$
JMP	—	Branches unconditionally to a specified address		
BSR	—	Branches to a subroutine at a specified address		
JSR	—	Branches to a subroutine at a specified address		
RTS	—	Returns from a subroutine		

Table 2.9 System Control Instructions

Instruction	Size*	Function
TRAPA	—	Starts trap-instruction exception handling
RTE	—	Returns from an exception-handling routine
SLEEP	—	Causes a transition to the power-down state
LDC	B/W	(EAs) → CCR Moves the source operand contents to the condition code register. The condition code register size is one byte, but in transfer from memory, data is read by word access.
STC	B/W	CCR → (EAd) Transfers the CCR contents to a destination location. The condition code register size is one byte, but in transfer to memory, data is written by word access.
ANDC	B	CCR ∧ #IMM → CCR Logically ANDs the condition code register with immediate data.
ORC	B	CCR ∨ #IMM → CCR Logically ORs the condition code register with immediate data.
XORC	B	CCR ⊕ #IMM → CCR Logically exclusive-ORs the condition code register with immediate data.
NOP	—	PC + 2 → PC Only increments the program counter.

Note: * Size refers to the operand size.
B: Byte
W: Word

Table 2.10 Block Transfer Instruction

Instruction	Size	Function
EEPMOV.B	—	if R4L ≠ 0 then repeat @ER5+ → @ER6+, R4L – 1 → R4L until R4L = 0 else next;
EEPMOV.W	—	if R4 ≠ 0 then repeat @ER5+ → @ER6+, R4 – 1 → R4 until R4 = 0 else next; Block transfer instruction. This instruction transfers the number of data bytes specified by R4L or R4, starting from the address indicated by ER5, to the location starting at the address indicated by ER6. At the end of the transfer, the next instruction is executed.

2.6.4 Basic Instruction Formats

The H8/300H instructions consist of 2-byte (1-word) units. An instruction consists of an operation field (OP field), a register field (r field), an effective address extension (EA field), and a condition field (cc field).

Operation Field: Indicates the function of the instruction, the addressing mode, and the operation to be carried out on the operand. The operation field always includes the first 4 bits of the instruction. Some instructions have two operation fields.

Register Field: Specifies a general register. Address registers are specified by 3 bits, data registers by 3 bits or 4 bits. Some instructions have two register fields. Some have no register field.

Effective Address Extension: 8, 16, or 32 bits specifying immediate data, an absolute address, or a displacement. A 24-bit address or displacement is treated as 32-bit data in which the first 8 bits are 0 (H'00).

Condition Field: Specifies the branching condition of Bcc instructions.

Figure 2.9 shows examples of instruction formats.

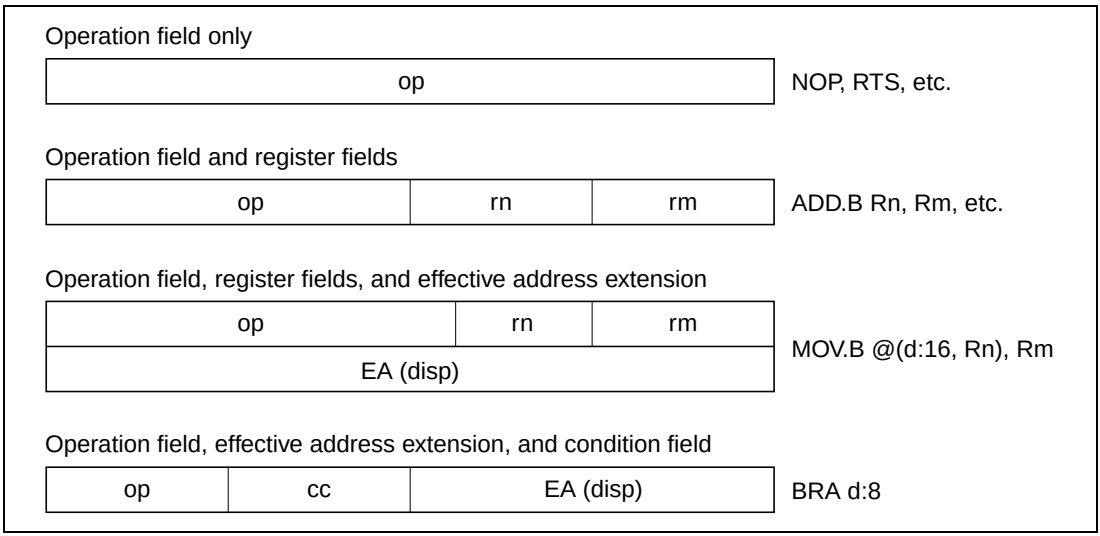


Figure 2.9 Instruction Formats

2.6.5 Notes on Use of Bit Manipulation Instructions

The BSET, BCLR, BNOT, BST, and BIST instructions read a byte of data, modify a bit in the byte, then write the byte back. Care is required when these instructions are used to access registers with write-only bits, or to access ports.

Step		Description
1	Read	Read one data byte at the specified address
2	Modify	Modify one bit in the data byte
3	Write	Write the modified data byte back to the specified address

Example 1: BCLR is executed to clear bit 0 in the port 4 data direction register (P4DDR) under the following conditions.

$P4_7$, $P4_6$: Input pins
$P4_5$ – $P4_0$: Output pins

The intended purpose of this BCLR instruction is to switch $P4_0$ from output to input.

Before Execution of BCLR Instruction

	$P4_7$	$P4_6$	$P4_5$	$P4_4$	$P4_3$	$P4_2$	$P4_1$	$P4_0$
Input/output	Input	Input	Output	Output	Output	Output	Output	Output
DDR	0	0	1	1	1	1	1	1

Execution of BCLR Instruction

```
BCLR  #0, @P4DDR      ;Clear bit 0 in data direction register
```

After Execution of BCLR Instruction

	$P4_7$	$P4_6$	$P4_5$	$P4_4$	$P4_3$	$P4_2$	$P4_1$	$P4_0$
Input/output	Output	Output	Output	Output	Output	Output	Output	Input
DDR	1	1	1	1	1	1	1	0

Explanation: To execute the BCLR instruction, the CPU begins by reading P4DDR. Since P4DDR is a write-only register, it is read as H'FF, even though its true value is H'3F.

Next the CPU clears bit 0 of the read data, changing the value to H'FE.

Finally, the CPU writes this value (H'FE) back to P4DDR to complete the BCLR instruction.

As a result, $P4_0$DDR is cleared to 0, making $P4_0$ an input pin. In addition, $P4_7$DDR and $P4_6$DDR are set to 1, making $P4_7$ and $P4_6$ output pins.

The BCLR instruction can be used to clear flags in the on-chip registers to 0. In an interrupt-handling routine, for example, if it is known that the flag is set to 1, it is not necessary to read the flag ahead of time.

2.7 Addressing Modes and Effective Address Calculation

2.7.1 Addressing Modes

The H8/300H CPU supports the eight addressing modes listed in table 2.11. Each instruction uses a subset of these addressing modes. Arithmetic and logic instructions can use the register direct and immediate modes. Data transfer instructions can use all addressing modes except program-counter relative and memory indirect. Bit manipulation instructions use register direct, register indirect, or absolute (@aa:8) addressing mode to specify an operand, and register direct (BSET, BCLR, BNOT, and BTST instructions) or immediate (3-bit) addressing mode to specify a bit number in the operand.

Table 2.11 Addressing Modes

No.	Addressing Mode	Symbol
1	Register direct	Rn
2	Register indirect	@ERn
3	Register indirect with displacement	@(d:16, ERn)/@(d:24, ERn)
4	Register indirect with post-increment Register indirect with pre-decrement	@ERn+ @–ERn
5	Absolute address	@aa:8/@aa:16/@aa:24
6	Immediate	#xx:8/#xx:16/#xx:32
7	Program-counter relative	@(d:8, PC)/@(d:16, PC)
8	Memory indirect	@@aa:8

1 Register Direct—Rn: The register field of the instruction code specifies an 8-, 16-, or 32-bit register containing the operand. R0H to R7H and R0L to R7L can be specified as 8-bit registers. R0 to R7 and E0 to E7 can be specified as 16-bit registers. ER0 to ER7 can be specified as 32-bit registers.

2 Register Indirect—@ERn: The register field of the instruction code specifies an address register (ERn), the lower 24 bits of which contain the address of the operand.

3 Register Indirect with Displacement—@(d:16, ERn) or @(d:24, ERn): A 16-bit or 24-bit displacement contained in the instruction code is added to the contents of an address register (ERn) specified by the register field of the instruction, and the lower 24 bits of the sum specify the address of a memory operand. A 16-bit displacement is sign-extended when added.

4 Register Indirect with Post-Increment or Pre-Decrement—@ERn+ or @–ERn:

- Register indirect with post-increment—@ERn+

  The register field of the instruction code specifies an address register (ERn) the lower 24 bits of which contain the address of a memory operand. After the operand is accessed, 1, 2, or 4 is added to the address register contents (32 bits) and the sum is stored in the address register. The value added is 1 for byte access, 2 for word access, or 4 for longword access. For word or longword access, the register value should be even.
- Register indirect with pre-decrement—@–ERn

  The value 1, 2, or 4 is subtracted from an address register (ERn) specified by the register field in the instruction code, and the lower 24 bits of the result become the address of a memory operand. The result is also stored in the address register. The value subtracted is 1 for byte access, 2 for word access, or 4 for longword access. For word or longword access, the resulting register value should be even.

5 Absolute Address—@aa:8, @aa:16, or @aa:24: The instruction code contains the absolute address of a memory operand. The absolute address may be 8 bits long (@aa:8), 16 bits long (@aa:16), or 24 bits long (@aa:24). For an 8-bit absolute address, the upper 16 bits are all assumed to be 1 (H'FFFF). For a 16-bit absolute address the upper 8 bits are a sign extension. A 24-bit absolute address can access the entire address space. Table 2.12 indicates the accessible address ranges.

Table 2.12 Absolute Address Access Ranges

Absolute Address	1-Mbyte Modes	16-Mbyte Modes
8 bits (@aa:8)	H'FFF00 to H'FFFFF (1048320 to 1048575)	H'FFFF00 to H'FFFFFF (16776960 to 16777215)
16 bits (@aa:16)	H'00000 to H'07FFF, H'F8000 to H'FFFFF (0 to 32767, 1015808 to 1048575)	H'000000 to H'007FFF, H'FF8000 to H'FFFFFF (0 to 32767, 16744448 to 16777215)
24 bits (@aa:24)	H'00000 to H'FFFFF (0 to 1048575)	H'000000 to H'FFFFFF (0 to 16777215)

6 Immediate—#xx:8, #xx:16, or #xx:32: The instruction code contains 8-bit (#xx:8), 16-bit (#xx:16), or 32-bit (#xx:32) immediate data as an operand.

The instruction codes of the ADDS, SUBS, INC, and DEC instructions contain immediate data implicitly. The instruction codes of some bit manipulation instructions contain 3-bit immediate data specifying a bit number. The TRAPA instruction code contains 2-bit immediate data specifying a vector address.

7 Program-Counter Relative—@(d:8, PC) or @(d:16, PC): This mode is used in the Bcc and BSR instructions. An 8-bit or 16-bit displacement contained in the instruction code is sign-extended to 24 bits and added to the 24-bit PC contents to generate a 24-bit branch address. The PC value to which the displacement is added is the address of the first byte of the next instruction, so the possible branching range is –126 to +128 bytes (–63 to +64 words) or –32766 to +32768 bytes (–16383 to +16384 words) from the branch instruction. The resulting value should be an even number.

8 Memory Indirect—@@aa:8: This mode can be used by the JMP and JSR instructions. The instruction code contains an 8-bit absolute address specifying a memory operand. This memory operand contains a branch address. The memory operand is accessed by longword access. The first byte of the memory operand is ignored, generating a 24-bit branch address. See figure 2.10. The upper bits of the 8-bit absolute address are assumed to be 0 (H'0000), so the address range is 0 to 255 (H'000000 to H'0000FF). Note that the first part of this range is also the exception vector area. For further details see section 5, Interrupt Controller.

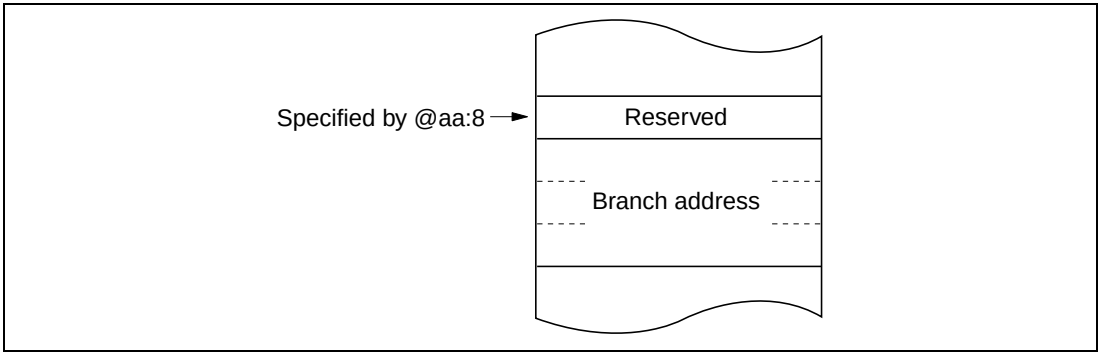


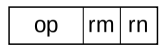
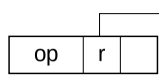
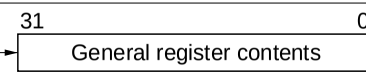
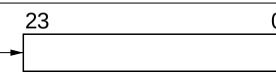
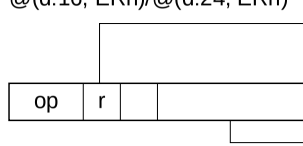
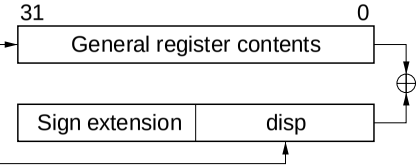
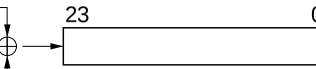
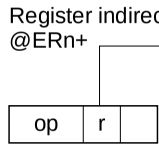
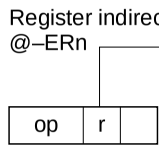
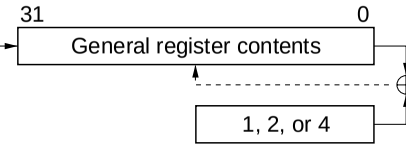
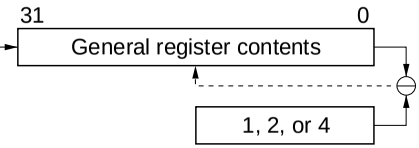
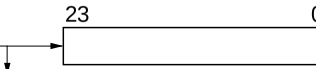
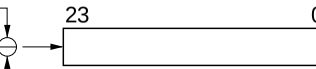
Figure 2.10 Memory-Indirect Branch Address Specification

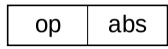
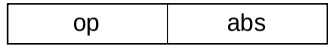
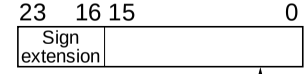
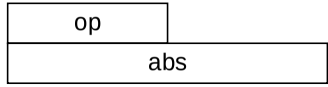
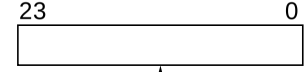
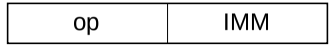
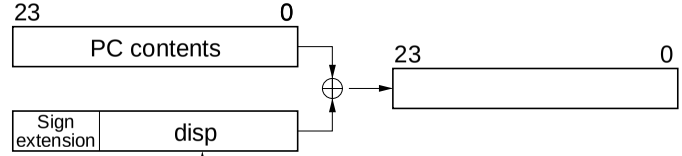
When a word-size or longword-size memory operand is specified, or when a branch address is specified, if the specified memory address is odd, the least significant bit is regarded as 0. The accessed data or instruction code therefore begins at the preceding address. See section 2.5.2, Memory Data Formats.

2.7.2 Effective Address Calculation

Table 2.13 explains how an effective address is calculated in each addressing mode. In the 1-Mbyte operating modes the upper 4 bits of the calculated address are ignored in order to generate a 20-bit effective address.

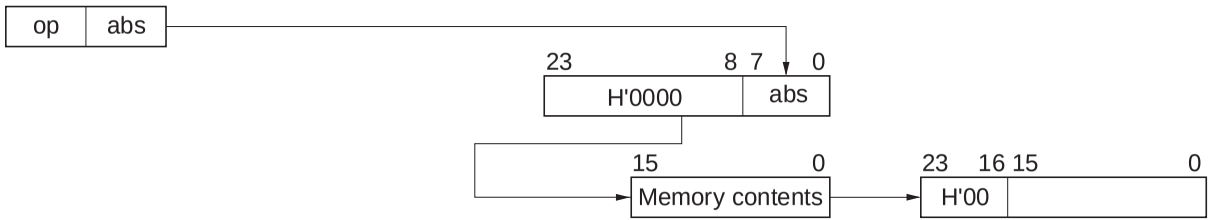
Table 2.13 Effective Address Calculation

No.	Addressing Mode and Instruction Format	Effective Address Calculation	Effective Address
1	Register direct (Rn) 		Operand is general register contents
2	Register indirect (@ERn) 		
3	Register indirect with displacement @(d:16, ERn)/@(d:24, ERn) 		
4	Register indirect with post-increment or pre-decrement Register indirect with post-increment @ERn+  Register indirect with pre-decrement @–ERn 	  1 for a byte operand, 2 for a word operand, 4 for a longword operand	 

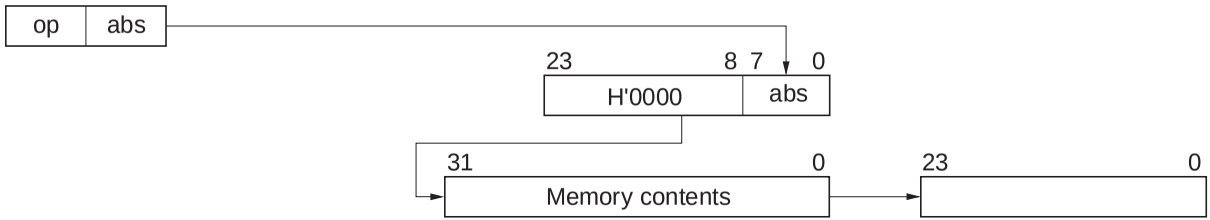
No.	Addressing Mode and Instruction Format	Effective Address Calculation	Effective Address
5	Absolute address @aa:8		
	@aa:16		
	@aa:24		
6	Immediate #xx:8, #xx:16, or #xx:32		Operand is immediate data
7	Program-counter relative @(d:8, PC) or @(d:16, PC)		

No.	Addressing Mode and Instruction Format	Effective Address Calculation	Effective Address
8	Memory indirect @@aa:8		

Normal mode



Advanced mode



[Legend]
r, rm, rn: Register field
op: Operation field
disp: Displacement
IMM: Immediate data
abs: Absolute address

2.8 Processing States

2.8.1 Overview

The H8/300H CPU has five processing states: the program execution state, exception-handling state, power-down state, reset state, and bus-released state. The power-down state includes sleep mode, software standby mode, and hardware standby mode. Figure 2.11 classifies the processing states. Figure 2.13 indicates the state transitions.

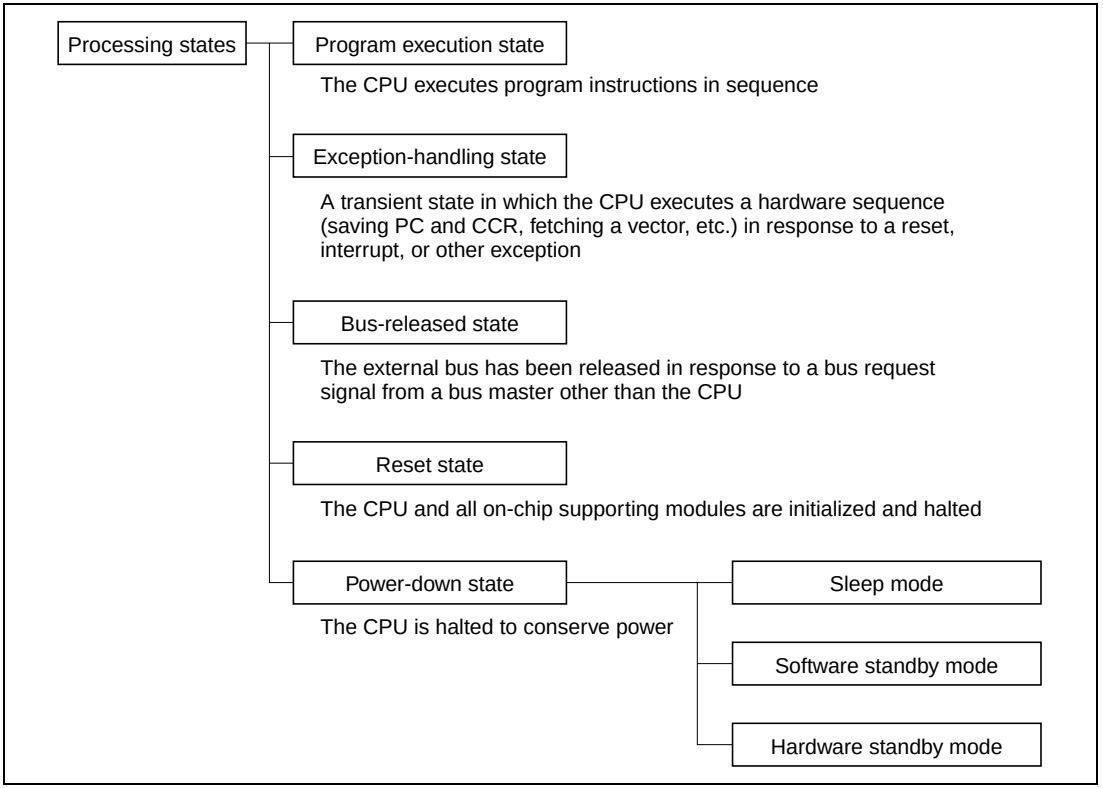


Figure 2.11 Processing States

2.8.2 Program Execution State

In this state the CPU executes program instructions in normal sequence.

2.8.3 Exception-Handling State

The exception-handling state is a transient state that occurs when the CPU alters the normal program flow due to a reset, interrupt, or trap instruction. The CPU fetches a starting address from the exception vector table and branches to that address. In interrupt and trap exception handling the CPU references the stack pointer (ER7) and saves the program counter and condition code register.

Types of Exception Handling and Their Priority: Exception handling is performed for resets, interrupts, and trap instructions. Table 2.14 indicates the types of exception handling and their priority. Trap instruction exceptions are accepted at all times in the program execution state.

Table 2.14 Exception Handling Types and Priority

Priority	Type of Exception	Detection Timing	Start of Exception Handling
High ↑	Reset	Synchronized with clock	Exception handling starts immediately when $\overline{\text{RES}}$ changes from low to high
	Interrupt	End of instruction execution or end of exception handling*	When an interrupt is requested, exception handling starts at the end of the current instruction or current exception-handling sequence
Low	Trap instruction	When TRAPA instruction is executed	Exception handling starts when a trap (TRAPA) instruction is executed

Note: * Interrupts are not detected at the end of the ANDC, ORC, XORC, and LDC instructions, or immediately after reset exception handling.

Figure 2.12 classifies the exception sources. For further details about exception sources, vector numbers, and vector addresses, see section 4, Exception Handling, and section 5, Interrupt Controller.

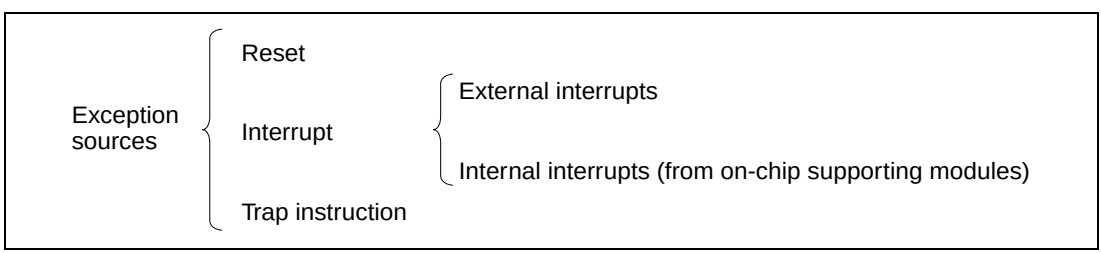
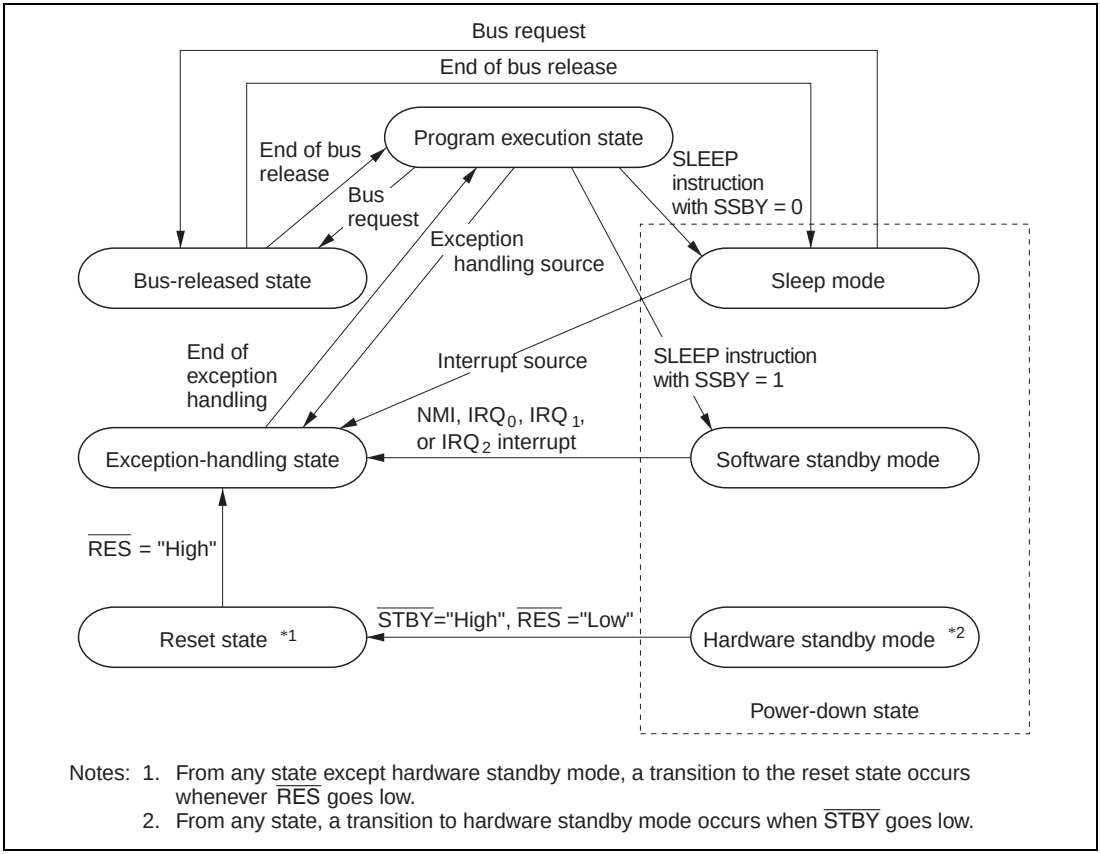


Figure 2.12 Classification of Exception Sources



Notes: 1. From any state except hardware standby mode, a transition to the reset state occurs whenever $\overline{RES}$ goes low.
2. From any state, a transition to hardware standby mode occurs when $\overline{STBY}$ goes low.

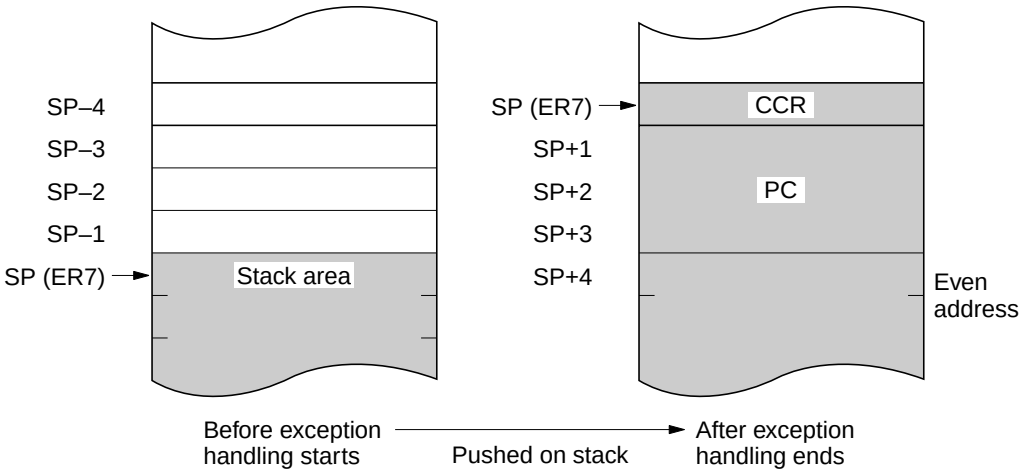
Figure 2.13 State Transitions

2.8.4 Exception-Handling Sequences

Reset Exception Handling: Reset exception handling has the highest priority. The reset state is entered when the $\overline{\text{RES}}$ signal goes low. Reset exception handling starts after that, when $\overline{\text{RES}}$ changes from low to high. When reset exception handling starts the CPU fetches a start address from the exception vector table and starts program execution from that address. All interrupts, including NMI, are disabled during the reset exception-handling sequence and immediately after it ends.

Interrupt Exception Handling and Trap Instruction Exception Handling: When these exception-handling sequences begin, the CPU references the stack pointer (ER7) and pushes the program counter and condition code register on the stack. Next, if the UE bit in the system control register (SYSCR) is set to 1, the CPU sets the I bit in the condition code register to 1. If the UE bit is cleared to 0, the CPU sets both the I bit and the UI bit in the condition code register to 1. Then the CPU fetches a start address from the exception vector table and execution branches to that address.

Figure 2.14 shows the stack after the exception-handling sequence.



Legend
CCR: Condition code register
SP: Stack pointer

Notes: 1. PC is the address of the first instruction executed after the return from the exception-handling routine.
2. Registers must be saved and restored by word access or longword access, starting at an even address.

Figure 2.14 Stack Structure after Exception Handling

2.8.5 Bus-Released State

In this state the bus is released to a bus master other than the CPU, in response to a bus request. The bus masters other than the CPU are the DMA controller, the DRAM interface, and an external bus master. While the bus is released, the CPU halts except for internal operations. Interrupt requests are not accepted. For details see section 6.10, Bus Arbiter.

2.8.6 Reset State

When the $\overline{\text{RES}}$ input goes low all current processing stops and the CPU enters the reset state. The I bit in the condition code register is set to 1 by a reset. All interrupts are masked in the reset state. Reset exception handling starts when the $\overline{\text{RES}}$ signal changes from low to high.

The reset state can also be entered by a watchdog timer overflow. For details see section 12, Watchdog Timer.

2.8.7 Power-Down State

In the power-down state the CPU stops operating to conserve power. There are three modes: sleep mode, software standby mode, and hardware standby mode.

Sleep Mode: A transition to sleep mode is made if the SLEEP instruction is executed while the SSBY bit is cleared to 0 in the system control register (SYSCR). CPU operations stop immediately after execution of the SLEEP instruction, but the contents of CPU registers are retained.

Software Standby Mode: A transition to software standby mode is made if the SLEEP instruction is executed while the SSBY bit is set to 1 in SYSCR. The CPU and clock halt and all on-chip supporting modules stop operating. The on-chip supporting modules are reset, but as long as a specified voltage is supplied the contents of CPU registers and on-chip RAM are retained. The I/O ports also remain in their existing states.

Hardware Standby Mode: A transition to hardware standby mode is made when the $\overline{\text{STBY}}$ input goes low. As in software standby mode, the CPU and all clocks halt and the on-chip supporting modules are reset, but as long as a specified voltage is supplied, on-chip RAM contents are retained.

For further information see section 20, Power-Down State.

2.9 Basic Operational Timing

2.9.1 Overview

The H8/300H CPU operates according to the system clock (ø). The interval from one rise of the system clock to the next rise is referred to as a "state." A memory cycle or bus cycle consists of two or three states. The CPU uses different methods to access on-chip memory, the on-chip supporting modules, and the external address space. Access to the external address space can be controlled by the bus controller.

2.9.2 On-Chip Memory Access Timing

On-chip memory is accessed in two states. The data bus is 16 bits wide, permitting both byte and word access. Figure 2.15 shows the on-chip memory access cycle. Figure 2.16 indicates the pin states.

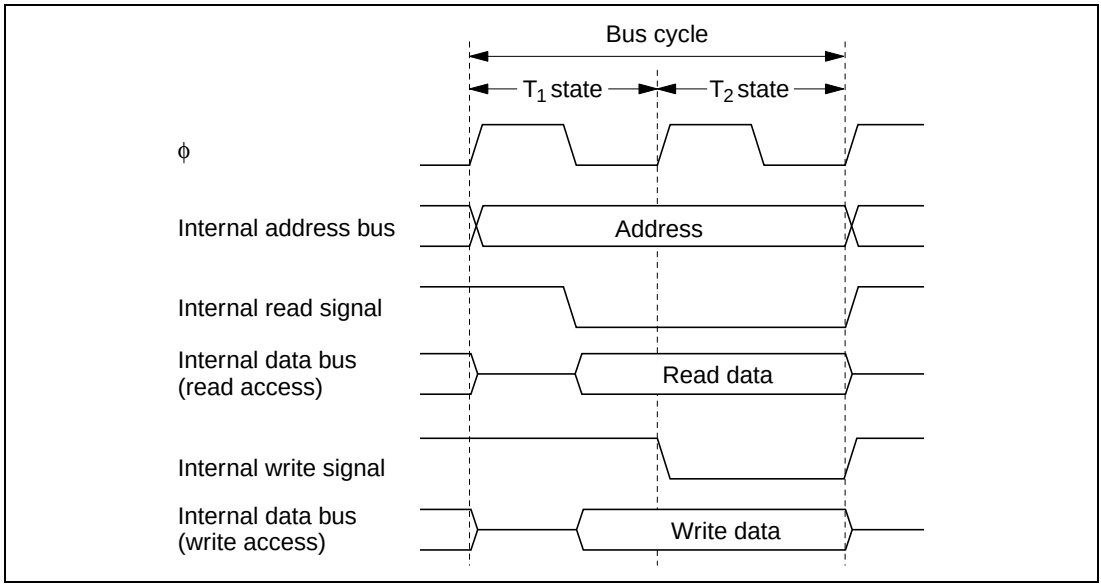


Figure 2.15 On-Chip Memory Access Cycle

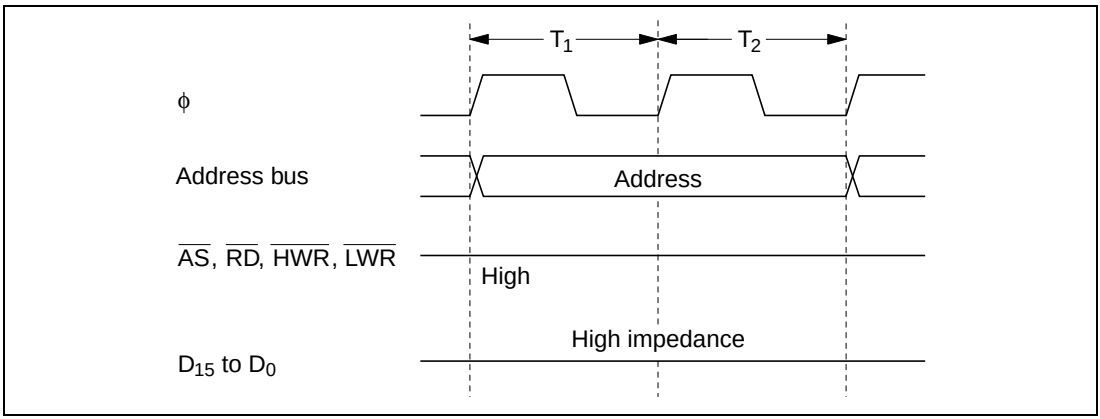


Figure 2.16 Pin States during On-Chip Memory Access

2.9.3 On-Chip Supporting Module Access Timing

The on-chip supporting modules are accessed in three states. The data bus is 8 or 16 bits wide, depending on the internal I/O register being accessed. Figure 2.17 shows the on-chip supporting module access timing. Figure 2.18 indicates the pin states.

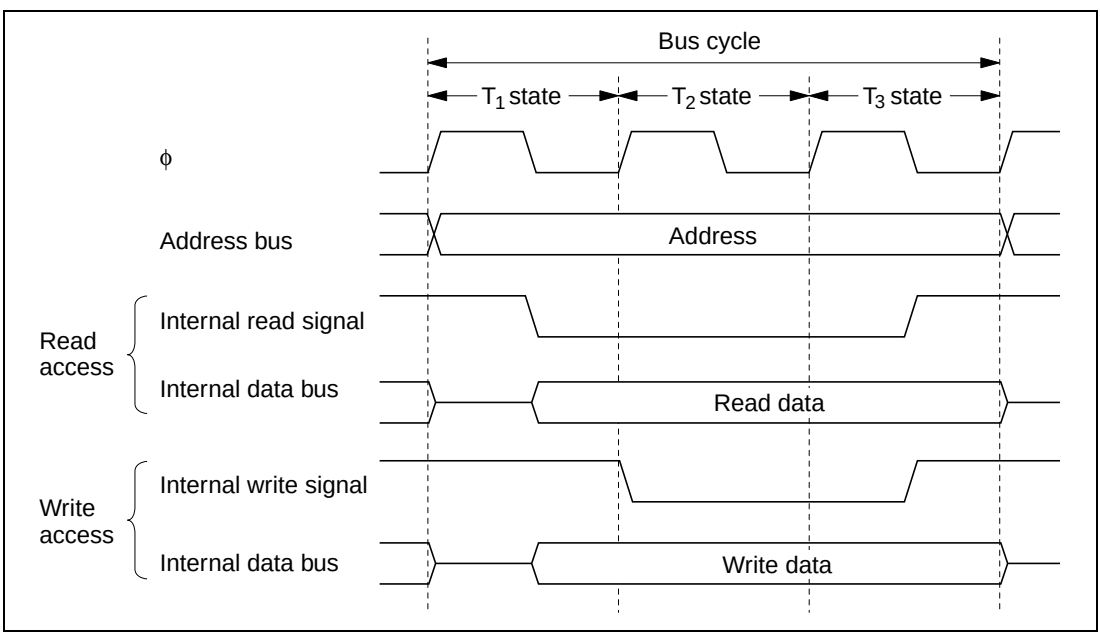


Figure 2.17 Access Cycle for On-Chip Supporting Modules

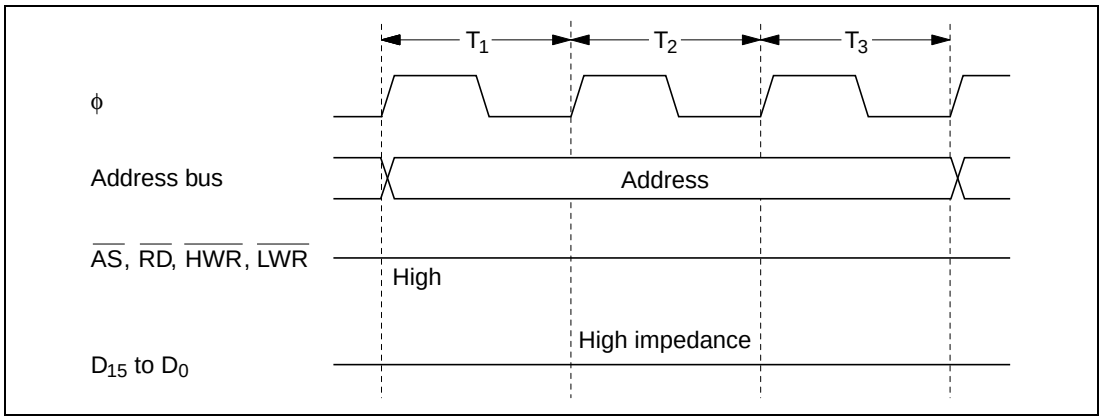


Figure 2.18 Pin States during Access to On-Chip Supporting Modules

2.9.4 Access to External Address Space

The external address space is divided into eight areas (areas 0 to 7). Bus-controller settings determine whether each area is accessed via an 8-bit or 16-bit bus, and whether it is accessed in two or three states. For details see section 6, Bus Controller.

Section 3 MCU Operating Modes

3.1 Overview

3.1.1 Operating Mode Selection

The H8/3069R has six operating modes (modes 1 to 5, 7) that are selected by the mode pins (MD_2 to MD_0) as indicated in table 3.1. The input at these pins determines the size of the address space and the initial bus mode.

Table 3.1 Operating Mode Selection

				Description			
Operating Mode	Mode Pins						
	MD_2	MD_1	MD_0	Address Space	Initial Bus Mode*[1]	On-Chip ROM	On-Chip RAM
—	0	0	0	—	—	—	—
Mode 1	0	0	1	Expanded mode	8 bits	Disabled	Enabled*[2]
Mode 2	0	1	0	Expanded mode	16 bits	Disabled	Enabled*[2]
Mode 3	0	1	1	Expanded mode	8 bits	Disabled	Enabled*[2]
Mode 4	1	0	0	Expanded mode	16 bits	Disabled	Enabled*[2]
Mode 5	1	0	1	Expanded mode	8 bits	Enabled	Enabled*[2]
—	1	1	0	—	—	—	—
Mode 7	1	1	1	Single-chip advanced mode	—	Enabled	Enabled

Notes: 1. In modes 1 to 5, an 8-bit or 16-bit data bus can be selected on a per-area basis by settings made in the area bus width control register (ABWCR). For details see section 6, Bus Controller.

2. If the RAME bit in SYSCR is cleared to 0, these addresses become external addresses.

For the address space size there are two choices: 1 Mbyte or 16 Mbyte.The external data bus is either 8 or 16 bits wide depending on ABWCR settings. If 8-bit access is selected for all areas, 8-bit bus mode is used. For details see section 6, Bus Controller.

Modes 1 to 4 are externally expanded modes that enable access to external memory and peripheral devices and disable access to the on-chip ROM. Modes 1 and 2 support a maximum address space of 1 Mbyte. Modes 3 and 4 support a maximum address space of 16 Mbytes.

Mode 5 is an externally expanded mode that enables access to external memory and peripheral devices and also enables access to the on-chip ROM. Mode 5 supports a maximum address space of 16 Mbytes.

Mode 7 are single-chip modes that operate using the on-chip ROM, RAM, and registers, and makes all I/O ports available. Mode 7 supports a maximum address space of 1 Mbyte.

The H8/3069R can be used only in modes 1 to 5, 7. The inputs at the mode pins must select one of these six modes. The inputs at the mode pins must not be changed during operation.

3.1.2 Register Configuration

The H8/3069R has a mode control register (MDCR) that indicates the inputs at the mode pins (MD_2 to MD_0), and a system control register (SYSCR). Table 3.2 summarizes these registers.

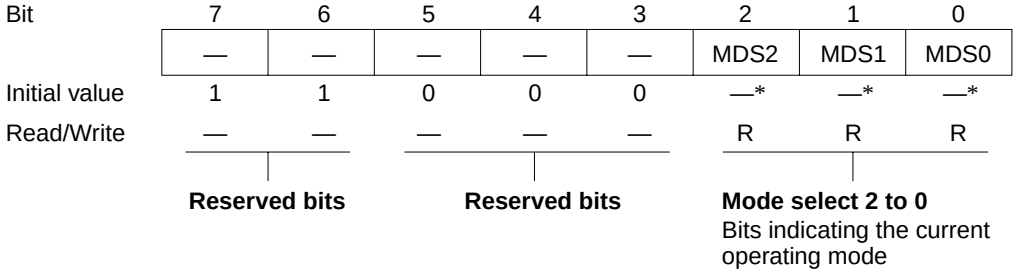
Table 3.2 Registers

Address*	Name	Abbreviation	R/W	Initial Value
H'EE011	Mode control register	MDCR	R	Undetermined
H'EE012	System control register	SYSCR	R/W	H'09

Note: * Lower 20 bits of the address in advanced mode.

3.2 Mode Control Register (MDCR)

MDCR is an 8-bit read-only register that indicates the current operating mode of the H8/3069R.



Note: * Determined by pins MD_2 to MD_0.

Bits 7 and 6—Reserved: These bits can not be modified and are always read as 1.

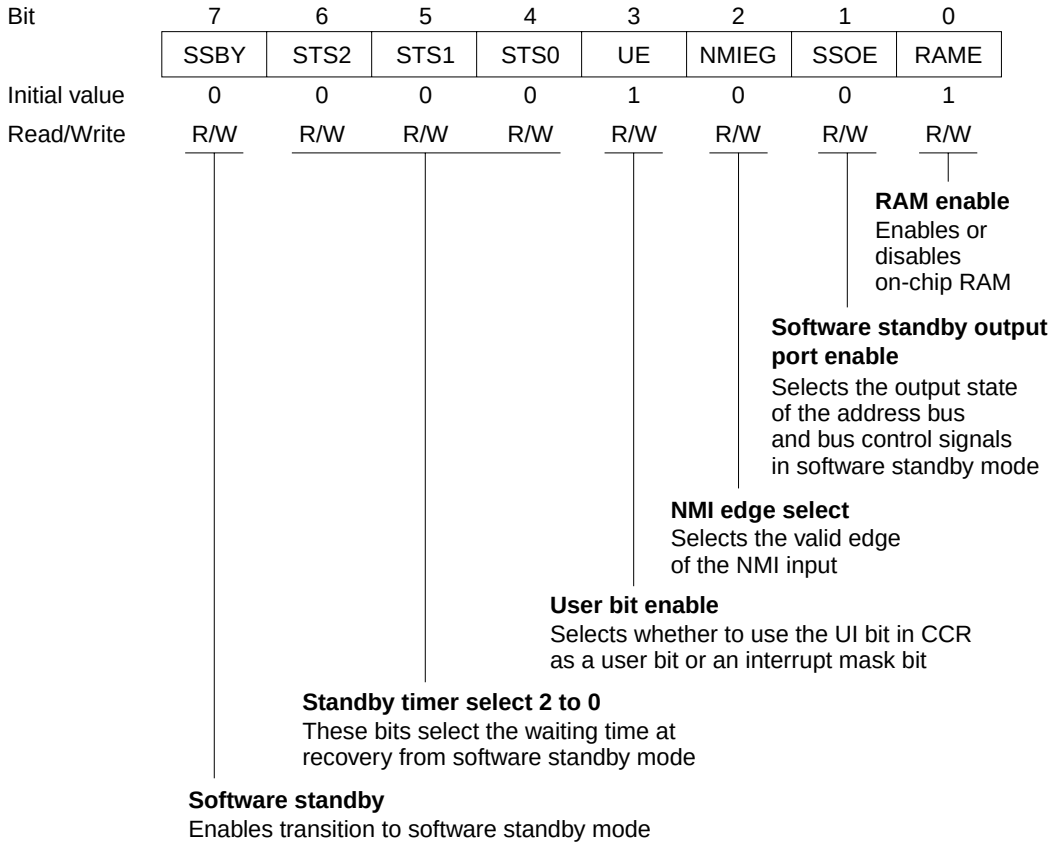
Bits 5 to 3—Reserved: These bits can not be modified and are always read as 0.

Bits 2 to 0—Mode Select 2 to 0 (MDS2 to MDS0): These bits indicate the logic levels at pins MD_2 to MD_0 (the current operating mode). MDS2 to MDS0 correspond to MD_2 to MD_0. MDS2 to MDS0 are read-only bits. The mode pin (MD_2 to MD_0) levels are latched into these bits when MDCR is read.

Note: A product with on-chip flash memory can operate in boot mode in which flash memory can be programmed. In boot mode, the MDS2 bit indicates the logic level at pin MD_2.

3.3 System Control Register (SYSCR)

SYSCR is an 8-bit register that controls the operation of the H8/3069R.



Bit 7—Software Standby (SSBY): Enables transition to software standby mode. (For further information about software standby mode see section 20, Power-Down State.)

When software standby mode is exited by an external interrupt, this bit remains set to 1. To clear this bit, write 0.

Bit 7 SSBY	Description	
0	SLEEP instruction causes transition to sleep mode	(Initial value)
1	SLEEP instruction causes transition to software standby mode	

Bits 6 to 4—Standby Timer Select 2 to 0 (STS2 to STS0): These bits select the length of time the CPU and on-chip supporting modules wait for the internal clock oscillator to settle when software standby mode is exited by an external interrupt.

When using a crystal oscillator, set these bits so that the waiting time will be at least 7 ms at the system clock rate.

For further information about waiting time selection, see section 20.4.3, Selection of Waiting Time for Exit from Software Standby Mode.

Bit 6 STS2	Bit 5 STS1	Bit 4 STS0	Description	
0	0	0	Waiting time = 8,192 states	(Initial value)
0	0	1	Waiting time = 16,384 states	
0	1	0	Waiting time = 32,768 states	
0	1	1	Waiting time = 65,536 states	
1	0	0	Waiting time = 131,072 states	
1	0	1	Waiting time = 262,144 states	
1	1	0	Waiting time = 1,024 states	
1	1	1	Illegal setting	

Bit 3—User Bit Enable (UE): Selects whether to use the UI bit in the condition code register as a user bit or an interrupt mask bit.

Bit 3 UE	Description	
0	UI bit in CCR is used as an interrupt mask bit	
1	UI bit in CCR is used as a user bit	(Initial value)

Bit 2—NMI Edge Select (NMIEG): Selects the valid edge of the NMI input.

Bit 2 NMIEG	Description	
0	An interrupt is requested at the falling edge of NMI	(Initial value)
1	An interrupt is requested at the rising edge of NMI	

Bit 1—Software Standby Output Port Enable (SSOE): Specifies whether the address bus and bus control signals ($\overline{CS_0}$ to $\overline{CS_7}$, $\overline{AS}$, $\overline{RD}$, $\overline{HWR}$, $\overline{LWR}$, $\overline{UCAS}$, $\overline{LCAS}$, and $\overline{RFSH}$) are kept as outputs or fixed high, or placed in the high-impedance state in software standby mode.

Bit 1 SSOE	Description
0	In software standby mode, the address bus and bus control signals are all high-impedance (Initial value)
1	In software standby mode, the address bus retains its output state and bus control signals are fixed high

Bit 0—RAM Enable (RAME): Enables or disables the on-chip RAM. The RAME bit is initialized by the rising edge of the $\overline{RES}$ signal. It is not initialized in software standby mode.

Bit 0 RAME	Description
0	On-chip RAM is disabled
1	On-chip RAM is enabled (Initial value)

3.4 Operating Mode Descriptions

3.4.1 Mode 1

Ports 1, 2, and 5 function as address pins A_{19} to A_0, permitting access to a maximum 1-Mbyte address space. The initial bus mode after a reset is 8 bits, with 8-bit access to all areas. If at least one area is designated for 16-bit access in ABWCR, the bus mode switches to 16 bits.

3.4.2 Mode 2

Ports 1, 2, and 5 function as address pins A_{19} to A_0, permitting access to a maximum 1-Mbyte address space. The initial bus mode after a reset is 16 bits, with 16-bit access to all areas. If all areas are designated for 8-bit access in ABWCR, the bus mode switches to 8 bits.

3.4.3 Mode 3

Ports 1, 2, 5, and part of port A function as address pins A_{23} to A_0, permitting access to a maximum 16-Mbyte address space. The initial bus mode after a reset is 8 bits, with 8-bit access to all areas. If at least one area is designated for 16-bit access in ABWCR, the bus mode switches to 16 bits. A_{23} to A_{21} are valid when 0 is written in bits 7 to 5 of the bus release control register (BRCR). (In this mode A_{20} is always used for address output.)

3.4.4 Mode 4

Ports 1, 2, 5, and part of port A function as address pins A_{23} to A_0, permitting access to a maximum 16-Mbyte address space. The initial bus mode after a reset is 16 bits, with 16-bit access to all areas. If all areas are designated for 8-bit access in ABWCR, the bus mode switches to 8 bits. A_{23} to A_{21} are valid when 0 is written in bits 7 to 5 of BRCR. (In this mode A_{20} is always used for address output.)

3.4.5 Mode 5

Ports 1, 2, 5, and part of port A can function as address pins A_{23} to A_0, permitting access to a maximum 16-Mbyte address space, but following a reset they are input ports. To use ports 1, 2, and 5 as an address bus, the corresponding bits in their data direction registers (P1DDR, P2DDR, and P5DDR) must be set to 1. For A_{23} to A_{20} output, write 0 in bits 7 to 4 of BRCR. Products with on-chip flash memory support on-board programming which enables programming of the flash memory. The initial bus mode after a reset is 8 bits, with 8-bit access to all areas. If at least one area is designated for 16-bit access in ABWCR, the bus mode switches to 16 bits.

3.4.6 Mode 7

This mode operates using the on-chip ROM, RAM, and registers. All I/O ports are available. Mode 7 supports a 1-Mbyte address space.

Products with on-chip flash memory support on-board programming which enables programming of the flash memory.

3.5 Pin Functions in Each Operating Mode

The pin functions of ports 1 to 5, A and port 6_7 vary depending on the operating mode. Table 3.3 indicates their functions in each operating mode.

Table 3.3 Pin Functions in Each Mode

Port	Mode 1	Mode 2	Mode 3	Mode 4	Mode 5	Mode 7
Port 1	A_7 to A_0	A_7 to A_0	A_7 to A_0	A_7 to A_0	$P1_7$ to $P1_0$*2	$P1_7$ to $P1_0$
Port 2	A_{15} to A_8	A_{15} to A_8	A_{15} to A_8	A_{15} to A_8	$P2_7$ to $P2_0$*2	$P2_7$ to $P2_0$
Port 3	D_{15} to D_8	D_{15} to D_8	D_{15} to D_8	D_{15} to D_8	D_{15} to D_8	$P3_7$ to $P3_0$
Port 4	$P4_7$ to $P4_0$*1	D_7 to D_0*1	$P4_7$ to $P4_0$*1	D_7 to D_0*1	$P4_7$ to $P4_0$*1	$P4_7$ to $P4_0$
Port 5	A_{19} to A_{16}	A_{19} to A_{16}	A_{19} to A_{16}	A_{19} to A_{16}	$P5_3$ to $P5_0$*2	$P5_3$ to $P5_0$
Port 6_7	ϕ*5	ϕ*5	ϕ*5	ϕ*5	ϕ*5	$P6_7$ *5
Port A	PA_7 to PA_4	PA_7 to PA_4	PA_6 to PA_4, A_{20}*3	PA_6 to PA_4, A_{20}*3	PA_7 to PA_4*4	PA_7 to PA_4

Notes:
1. Initial state. The bus mode can be switched by settings in ABWCR. These pins function as $P4_7$ to $P4_0$ in 8-bit bus mode, and as D_7 to D_0 in 16-bit bus mode.
2. Initial state. These pins become address output pins when the corresponding bits in the data direction registers (P1DDR, P2DDR, P5DDR) are set to 1.
3. Initial state. A_{20} is always an address output pin. PA_6 to PA_4 are switched over to A_{23} to A_{21} output by writing 0 in bits 7 to 5 of BRCR.
4. Initial state. PA_7 to PA_4 are switched over to A_{23} to A_{20} output by writing 0 in bits 7 to 4 of BRCR.
5. Initial state. In modes 1 to 5 ϕ_{12} can be set as $P6_7$ by writing 1 to bit 7 in MSTCRH. In mode 7 $P6_7$ can be set to ϕ output by writing 0 to bit 7 in MSTCRH.

3.6 Memory Map in Each Operating Mode

Figures 3.1 and 3.2 show memory maps of the H8/3069R. The address space is divided into eight areas.

The EMC bit in BCR can be read and written to select either of the two memory maps. For details, see section 6.2.5, Bus Control Register (BCR).

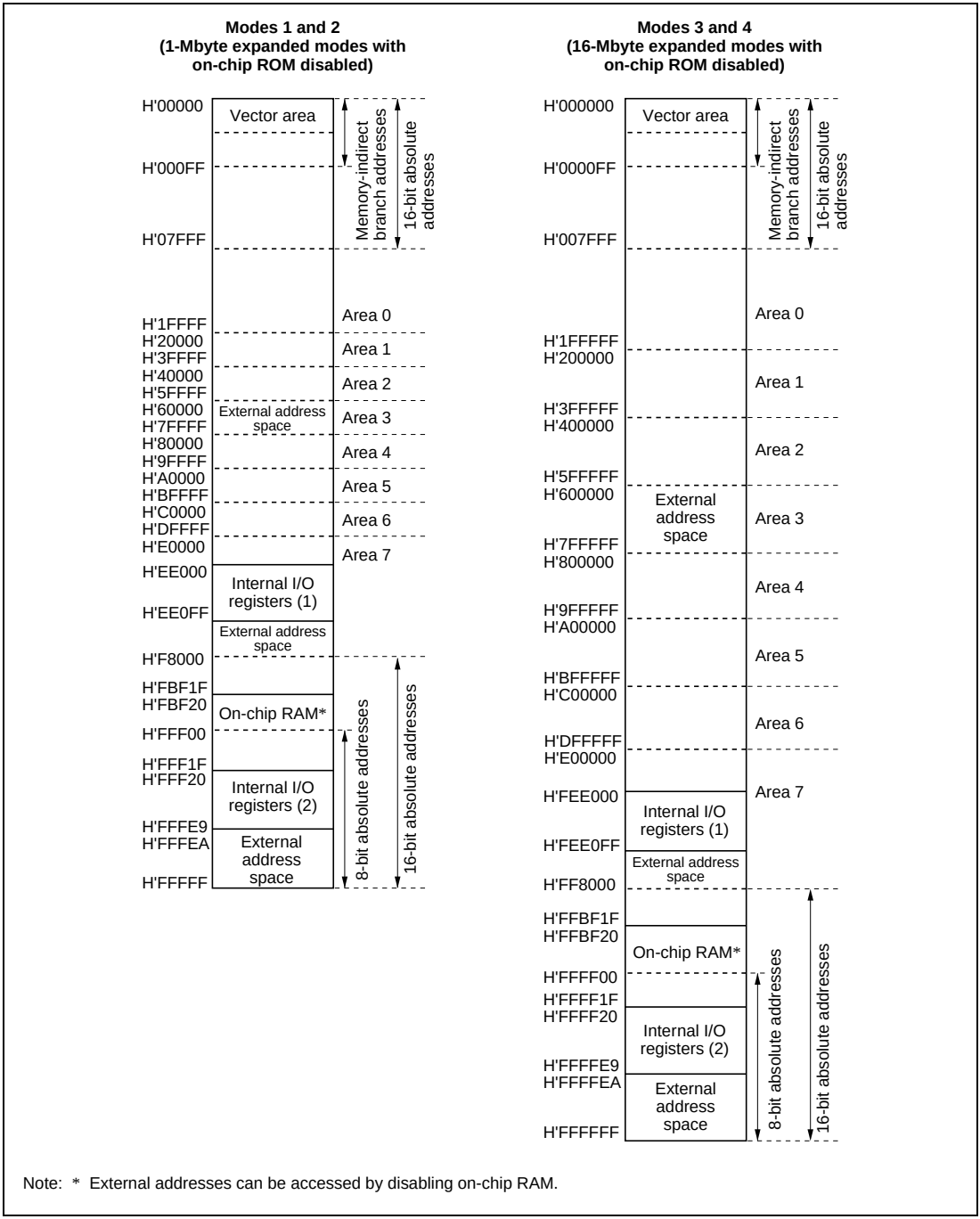
The initial bus mode differs between modes 1 and 2, and also between modes 3 and 4.

The address locations of the on-chip RAM and on-chip registers differ between the 1-Mbyte modes (modes 1, 2, and 7), and the 16-Mbyte modes (modes 3, 4, and 5). The address range specifiable by the CPU in the 8- and 16-bit absolute addressing modes (@aa:8 and @aa:16) also differs.

3.6.1 Note on Reserved Areas

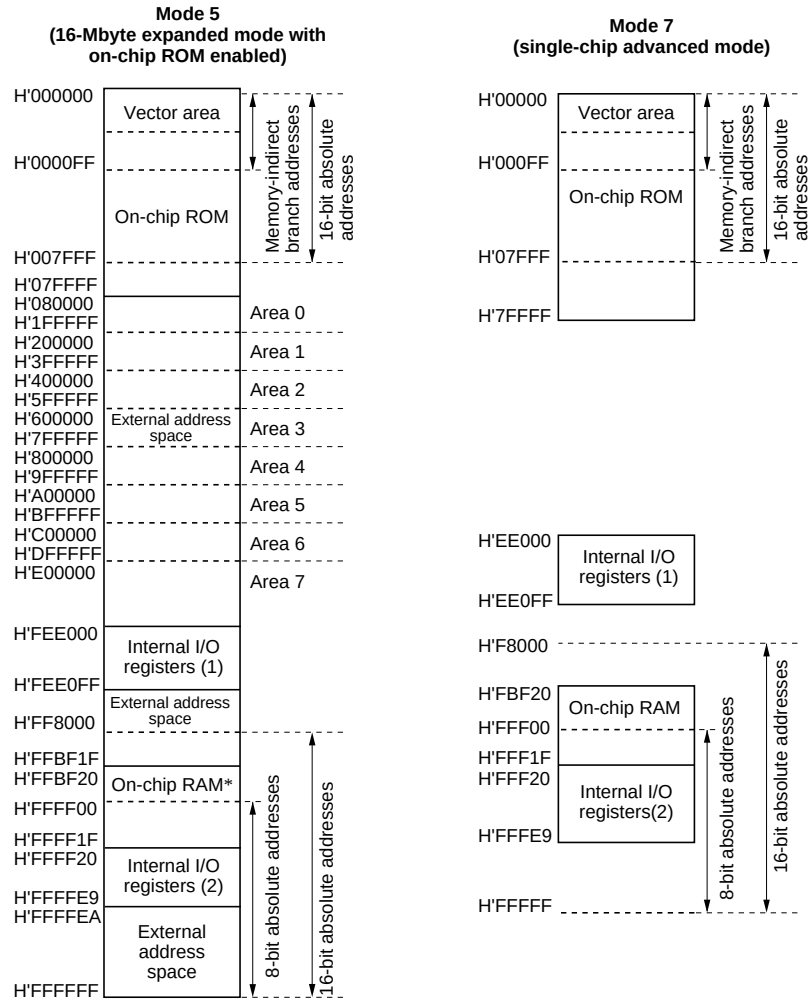
The H8/3069R memory map includes reserved areas to which read/write access is prohibited. Note that normal operation is not guaranteed if the following reserved areas are accessed.

- The reserved area in the internal I/O register space.
  The H8/3069R internal I/O register space includes a reserved area to which access is prohibited. For details see appendix B, Internal I/O Registers.



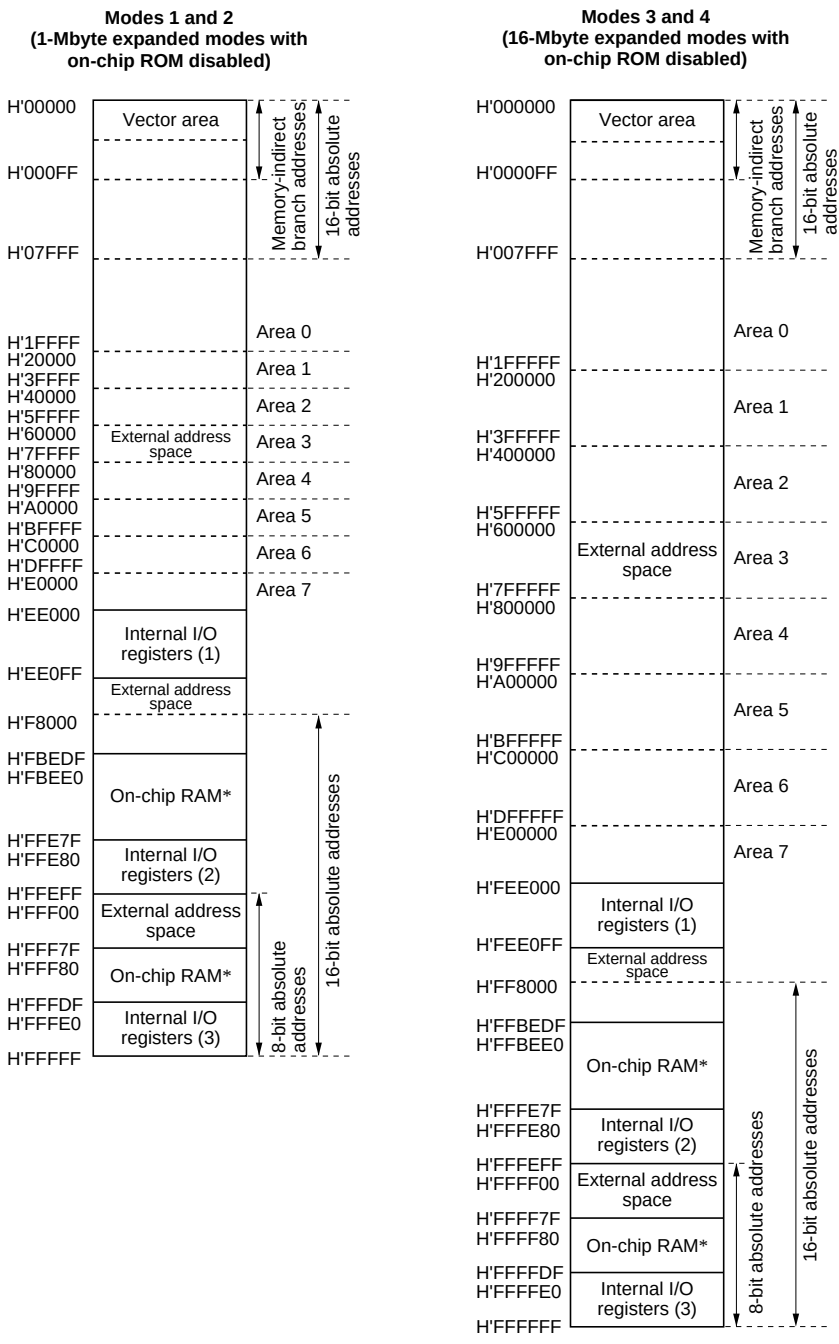
Note: * External addresses can be accessed by disabling on-chip RAM.

Figure 3.1(1) H8/3069R Memory Map in Each Operating Mode (EMC = 1)



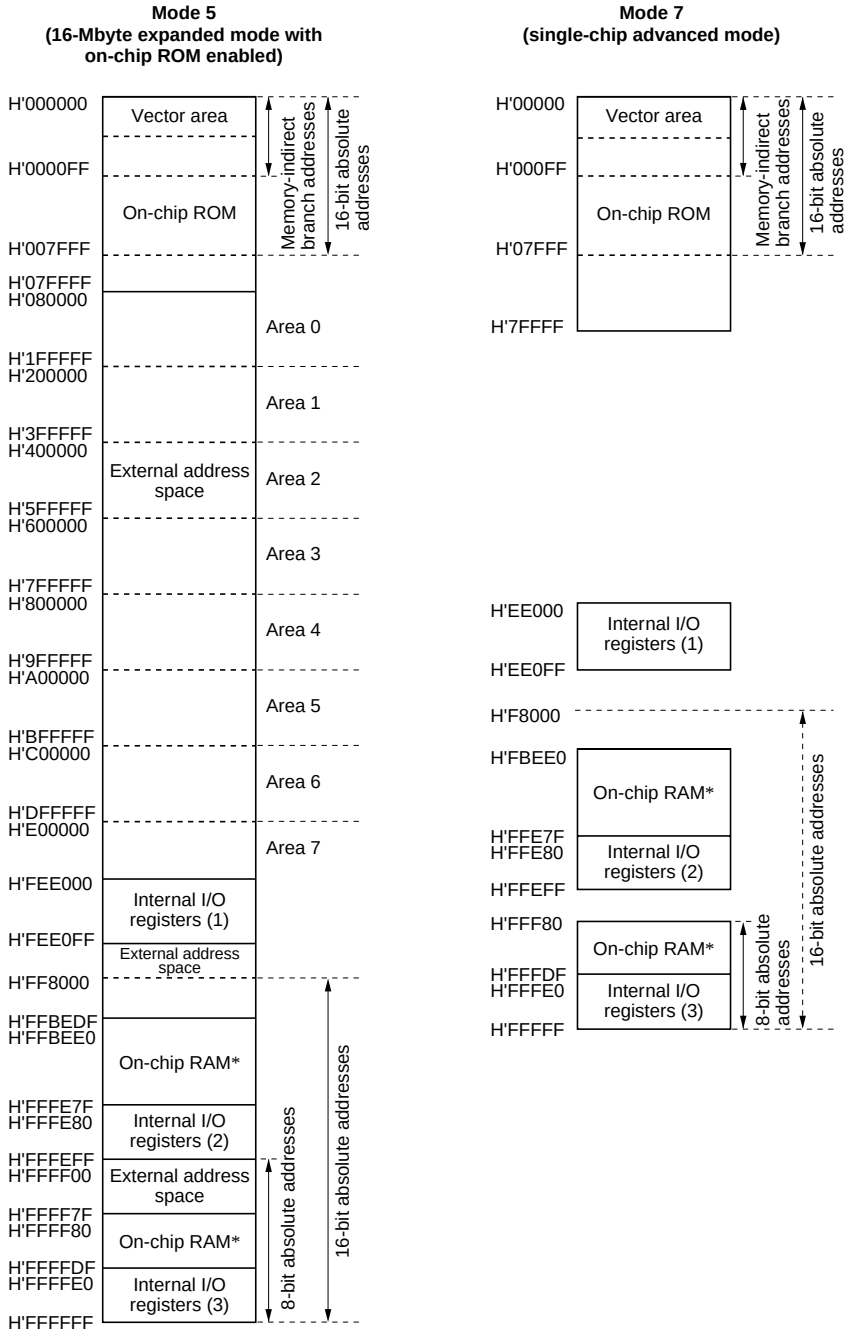
Note: * External addresses can be accessed by disabling on-chip RAM.

Figure 3.1(2) H8/3069R Memory Map in Each Operating Mode (EMC = 1)



Note: * This area becomes external address space when on-chip RAM is disabled.

Figure 3.2(1) H8/3069R Memory Map in Each Operating Mode (EMC = 0)



Note: * This area becomes external address space when on-chip RAM is disabled.

Figure 3.2(2) H8/3069R Memory Map in Each Operating Mode (EMC = 0)

Section 4 Exception Handling

4.1 Overview

4.1.1 Exception Handling Types and Priority

As table 4.1 indicates, exception handling may be caused by a reset, trap instruction, or interrupt. Exception handling is prioritized as shown in table 4.1. If two or more exceptions occur simultaneously, they are accepted and processed in priority order. Trap instruction exceptions are accepted at all times in the program execution state.

Table 4.1 Exception Types and Priority

Priority	Exception Type	Start of Exception Handling
High	Reset	Starts immediately after a low-to-high transition at the $\overline{\text{RES}}$ pin
↑	Interrupt	Interrupt requests are handled when execution of the current instruction or handling of the current exception is completed
Low	Trap instruction (TRAPA)	Started by execution of a trap instruction (TRAPA)

4.1.2 Exception Handling Operation

Exceptions originate from various sources. Trap instructions and interrupts are handled as follows.

1. The program counter (PC) and condition code register (CCR) are pushed onto the stack.
2. The CCR interrupt mask bit is set to 1.
3. A vector address corresponding to the exception source is generated, and program execution starts from that address.

Note: For a reset exception, steps 2 and 3 above are carried out.

4.1.3 Exception Vector Table

The exception sources are classified as shown in figure 4.1. Different vectors are assigned to different exception sources. Table 4.2 lists the exception sources and their vector addresses.

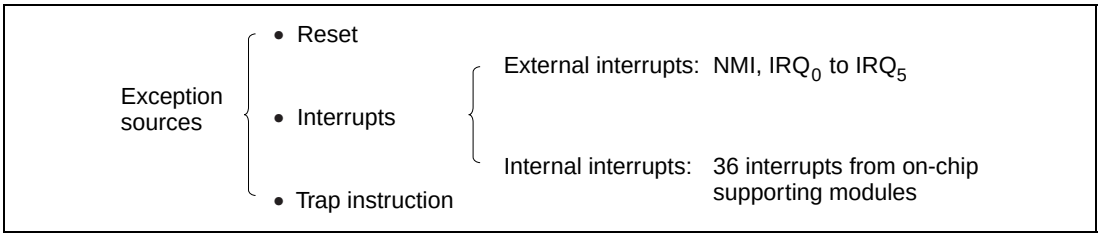


Figure 4.1 Exception Sources

Table 4.2 Exception Vector Table

Exception Source	Vector Number	Vector Address*[1]	
		Advanced Mode	Normal Mode*[3]
Reset	0	H'0000 to H'0003	H'0000 to H'0001
Reserved for system use	1	H'0004 to H'0007	H'0002 to H'0003
	2	H'0008 to H'000B	H'0004 to H'0005
	3	H'000C to H'000F	H'0006 to H'0007
	4	H'0010 to H'0013	H'0008 to H'0009
	5	H'0014 to H'0017	H'000A to H'000B
	6	H'0018 to H'001B	H'000C to H'000D
External interrupt (NMI)	7	H'001C to H'001F	H'000E to H'000F
Trap instruction (4 sources)	8	H'0020 to H'0023	H'0010 to H'0011
	9	H'0024 to H'0027	H'0012 to H'0013
	10	H'0028 to H'002B	H'0014 to H'0015
	11	H'002C to H'002F	H'0016 to H'0017
External interrupt IRQ_0	12	H'0030 to H'0033	H'0018 to H'0019
External interrupt IRQ_1	13	H'0034 to H'0037	H'001A to H'001B
External interrupt IRQ_2	14	H'0038 to H'003B	H'001C to H'001D
External interrupt IRQ_3	15	H'003C to H'003F	H'001E to H'001F
External interrupt IRQ_4	16	H'0040 to H'0043	H'0020 to H'0021
External interrupt IRQ_5	17	H'0044 to H'0047	H'0022 to H'0023
Reserved for system use	18	H'0048 to H'004B	H'0024 to H'0025
	19	H'004C to H'004F	H'0026 to H'0027
Internal interrupts*[2]	20 to 63	H'0050 to H'0053 to H'00FC to H'00FF	H'0028 to H'0029 to H'007E to H'007F

Notes: 1. Lower 16 bits of the address.
2. For the internal interrupt vectors, see section 5.3.3, Interrupt Vector Table.
3. Cannot be selected in H8/3069R.

4.2 Reset

4.2.1 Overview

A reset is the highest-priority exception. When the $\overline{\text{RES}}$ pin goes low, all processing halts and the chip enters the reset state. A reset initializes the internal state of the CPU and the registers of the on-chip supporting modules. Reset exception handling begins when the $\overline{\text{RES}}$ pin changes from low to high.

The chip can also be reset by overflow of the watchdog timer. For details see section 12, Watchdog Timer.

4.2.2 Reset Sequence

The chip enters the reset state when the $\overline{\text{RES}}$ pin goes low.

To ensure that the chip is reset, hold the $\overline{\text{RES}}$ pin low for at least 20 ms at power-up. To reset the chip during operation, hold the $\overline{\text{RES}}$ pin low for at least 20 system clock (ϕ) cycles. See appendix D.2, Pin States at Reset, for the states of the pins in the reset state.

When the $\overline{\text{RES}}$ pin goes high after being held low for the necessary time, the chip starts reset exception handling as follows.

- The internal state of the CPU and the registers of the on-chip supporting modules are initialized, and the I bit is set to 1 in CCR.
- The contents of the reset vector address (H'0000 to H'0003 in advanced mode, H'0000 to H'0001 in normal mode) are read, and program execution starts from the address indicated in the vector address.

Note : The normal mode cannot be selected in the H8/3069R

Figure 4.2 shows the reset sequence in modes 1 and 3. Figure 4.3 shows the reset sequence in modes 2 and 4.

- After power is turned on, hold the $\overline{\text{RES}}$ pin low and the $\overline{\text{STBY}}$ pin high.

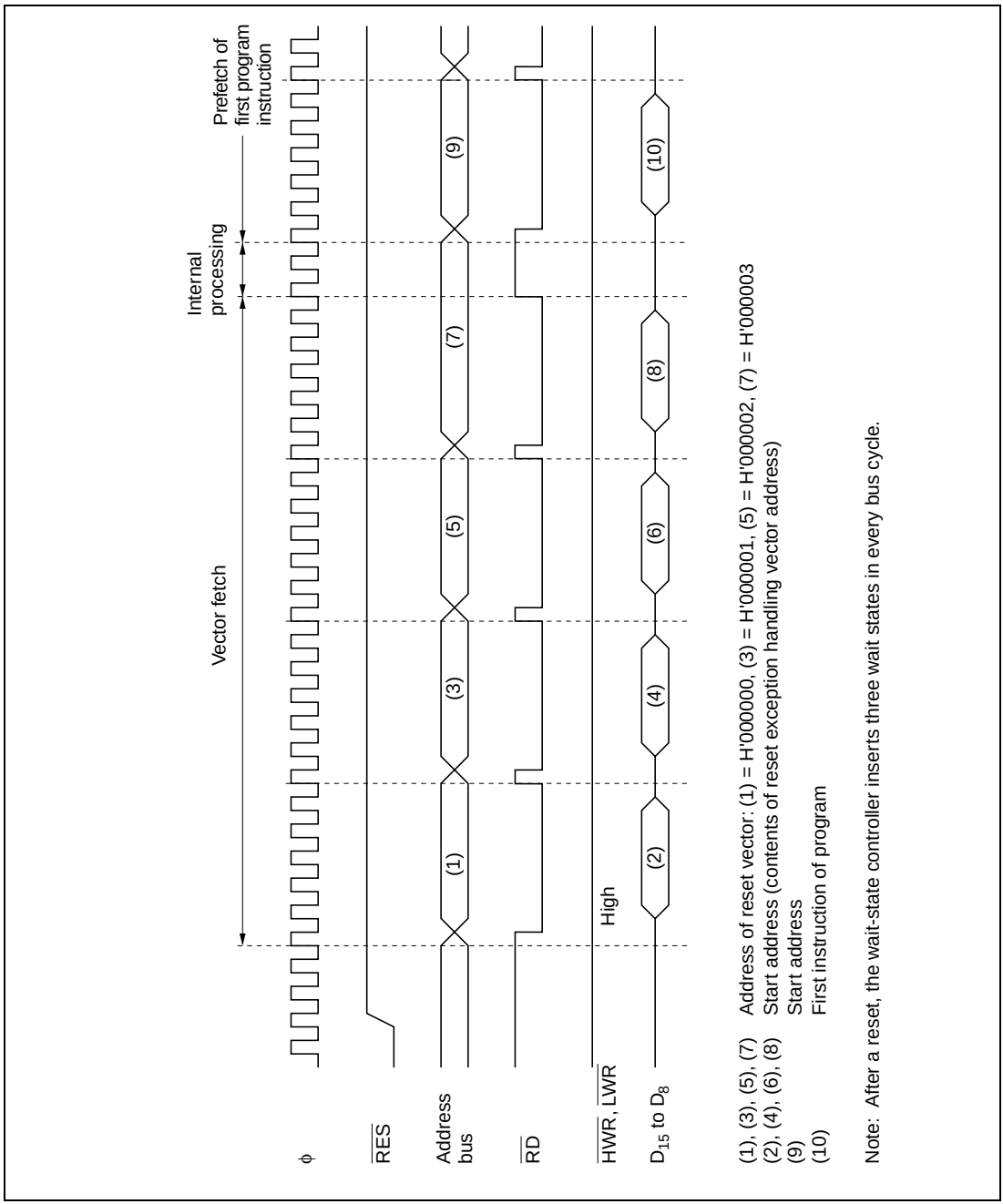
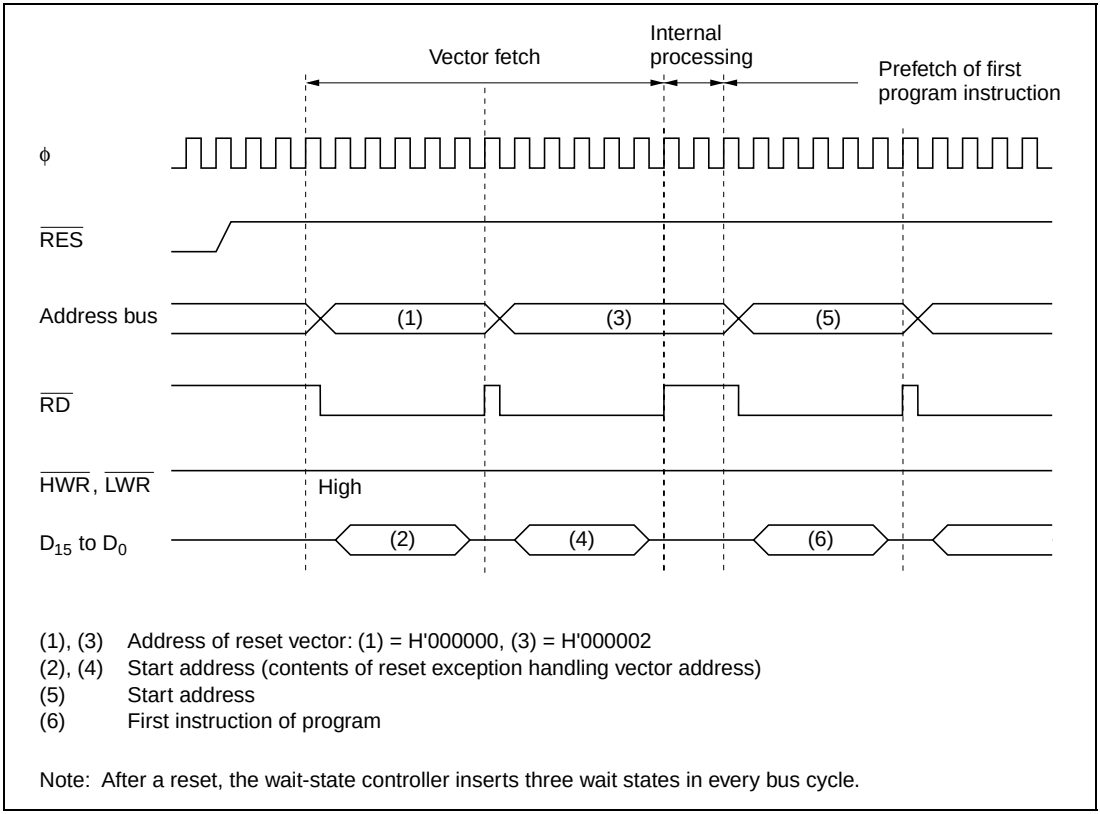


Figure 4.2 Reset Sequence (Modes 1 and 3)



(1), (3) Address of reset vector: (1) = H'000000, (3) = H'000002
(2), (4) Start address (contents of reset exception handling vector address)
(5) Start address
(6) First instruction of program

Note: After a reset, the wait-state controller inserts three wait states in every bus cycle.

Figure 4.3 Reset Sequence (Modes 2 and 4)

4.2.3 Interrupts after Reset

If an interrupt is accepted after a reset but before the stack pointer (SP) is initialized, PC and CCR will not be saved correctly, leading to a program crash. To prevent this, all interrupt requests, including NMI, are disabled immediately after a reset. The first instruction of the program is always executed immediately after the reset state ends. This instruction should initialize the stack pointer (example: MOV.L #xx:32, SP).

4.3 Interrupts

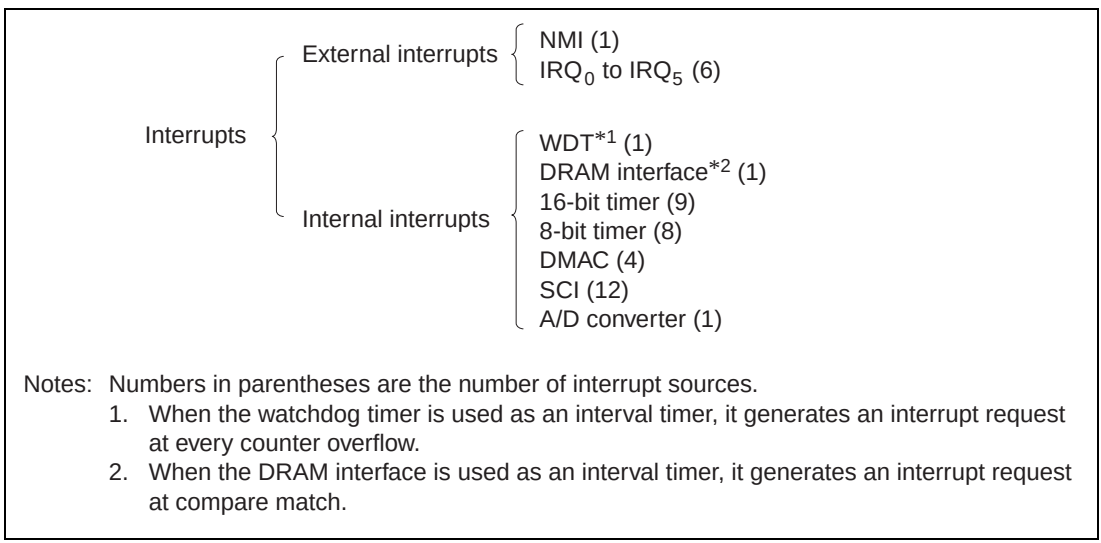
Interrupt exception handling can be requested by seven external sources (NMI, IRQ_0 to IRQ_5), and 36 internal sources in the on-chip supporting modules. Figure 4.4 classifies the interrupt sources and indicates the number of interrupts of each type.

The on-chip supporting modules that can request interrupts are the watchdog timer (WDT), DRAM interface, 16-bit timer, 8-bit timer, DMA controller (DMAC), serial communication interface (SCI), and A/D converter. Each interrupt source has a separate vector address.

NMI is the highest-priority interrupt and is always accepted*. Interrupts are controlled by the interrupt controller. The interrupt controller can assign interrupts other than NMI to two priority levels, and arbitrate between simultaneous interrupts. Interrupt priorities are assigned in interrupt priority registers A and B (IPRA and IPRB) in the interrupt controller.

Note: * NMI input is sometimes disabled when flash memory is being programmed or erased. For details see section 18.4.5 Flash Vector Address Control Register (FVACR).

For details on interrupts see section 5, Interrupt Controller.



Notes: Numbers in parentheses are the number of interrupt sources.
1. When the watchdog timer is used as an interval timer, it generates an interrupt request at every counter overflow.
2. When the DRAM interface is used as an interval timer, it generates an interrupt request at compare match.

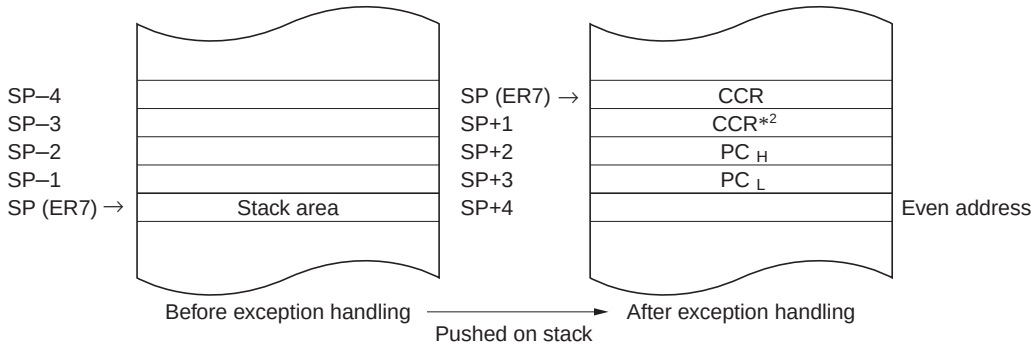
Figure 4.4 Interrupt Sources and Number of Interrupts

4.4 Trap Instruction

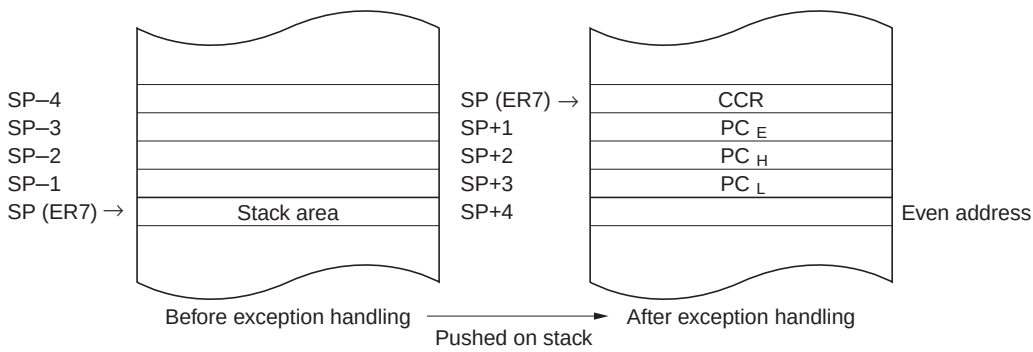
Trap instruction exception handling starts when a TRAPA instruction is executed. If the UE bit is set to 1 in the system control register (SYSCR), the exception handling sequence sets the I bit to 1 in CCR. If the UE bit is 0, the I and UI bits are both set to 1. The TRAPA instruction fetches a start address from a vector table entry corresponding to a vector number from 0 to 3, which is specified in the instruction code.

4.5 Stack Status after Exception Handling

Figure 4.5 shows the stack after completion of trap instruction exception handling and interrupt exception handling.



a. Normal mode*1



b. Advanced mode

[Legend]
PCE: Bits 23 to 16 of program counter (PC)
PCH: Bits 15 to 8 of program counter (PC)
PCL: Bits 7 to 0 of program counter (PC)
CCR: Condition code register
SP: Stack pointer

Notes: 1. Cannot be selected in H8/3069R
2. Ignored at return.
- PC indicates the address of the first instruction that will be executed after return.
- Registers must be saved in word or longword size at even addresses.

Figure 4.5 Stack after Completion of Exception Handling

4.6 Notes on Stack Usage

When accessing word data or longword data, the H8/3069R regards the lowest address bit as 0. The stack should always be accessed by word access or longword access, and the value of the stack pointer (SP, ER7) should always be kept even.

Use the following instructions to save registers:

PUSH.W Rn (or MOV.W Rn, @–SP)

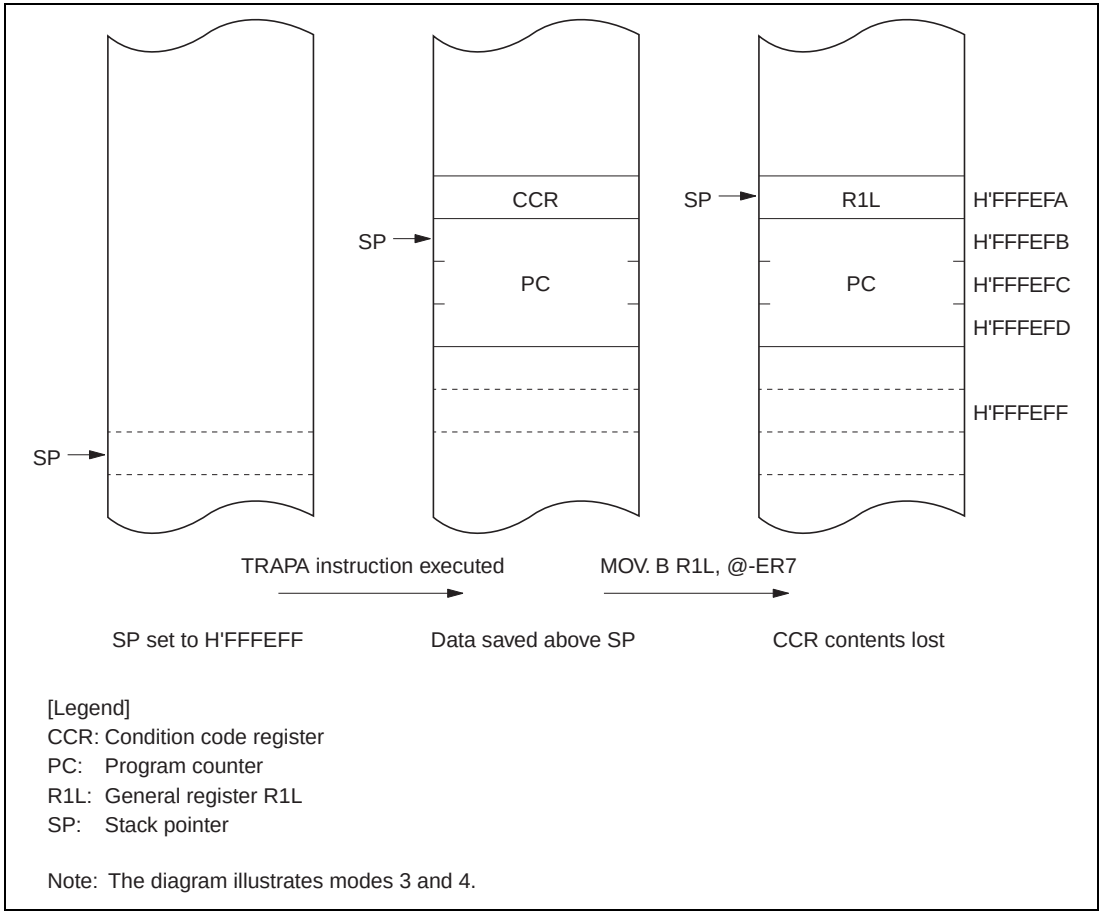
PUSH.L ERn (or MOV.L ERn, @–SP)

Use the following instructions to restore registers:

POP.W Rn (or MOV.W @SP+, Rn)

POP.L ERn (or MOV.L @SP+, ERn)

Setting SP to an odd value may lead to a malfunction. Figure 4.6 shows an example of what happens when the SP value is odd.



[Legend]
CCR: Condition code register
PC: Program counter
R1L: General register R1L
SP: Stack pointer

Note: The diagram illustrates modes 3 and 4.

Figure 4.6 Operation when SP Value is Odd

Section 5 Interrupt Controller

5.1 Overview

5.1.1 Features

The interrupt controller has the following features:

- Interrupt priority registers (IPRs) for setting interrupt priorities
  Interrupts other than NMI can be assigned to two priority levels on a module-by-module basis in interrupt priority registers A and B (IPRA and IPRB).
- Three-level masking by the I and UI bits in the CPU condition code register (CCR)
- Seven external interrupt pins
  NMI has the highest priority and is always accepted*; either the rising or falling edge can be selected. For each of $\overline{IRQ}_0$ to $\overline{IRQ}_5$, sensing of the falling edge or level sensing can be selected independently.

Note: * NMI input is sometimes disabled when flash memory is being programmed or erased. For details see section 18.4.5 Flash Vector Address Control Register (FVACR).

5.1.2 Block Diagram

Figure 5.1 shows a block diagram of the interrupt controller.

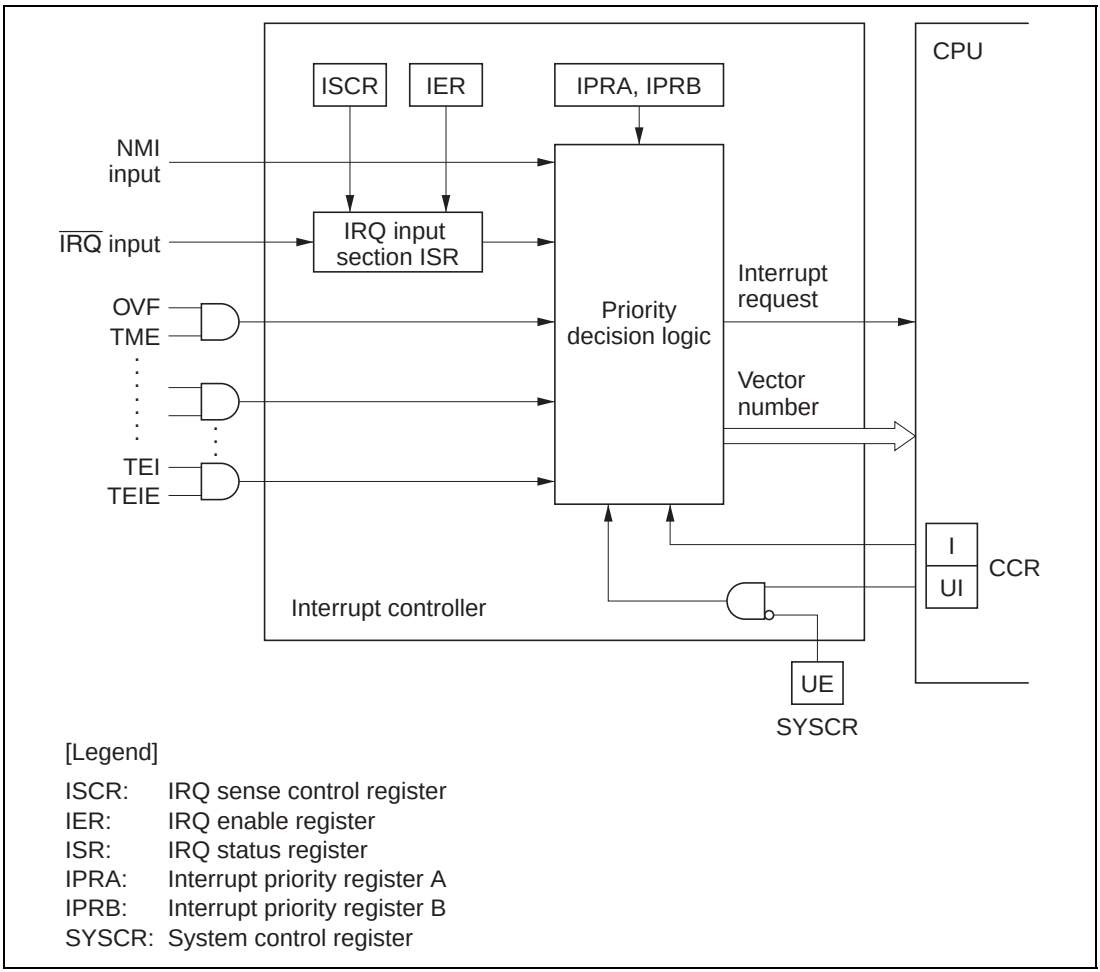


Figure 5.1 Interrupt Controller Block Diagram

5.1.3 Pin Configuration

Table 5.1 lists the interrupt pins.

Table 5.1 Interrupt Pins

Name	Abbreviation	I/O	Function
Nonmaskable interrupt	NMI	Input	Nonmaskable interrupt*, rising edge or falling edge selectable
External interrupt request 5 to 0	$\overline{IRQ}_5$ to $\overline{IRQ}_0$	Input	Maskable interrupts, falling edge or level sensing selectable

Note: * NMI input is sometimes disabled when flash memory is being programmed or erased. For details see section 18.4.5, Flash Vector Address Control Register (FVACR).

5.1.4 Register Configuration

Table 5.2 lists the registers of the interrupt controller.

Table 5.2 Interrupt Controller Registers

Address*[1]	Name	Abbreviation	R/W	Initial Value
H'EE012	System control register	SYSCR	R/W	H'09
H'EE014	IRQ sense control register	ISCR	R/W	H'00
H'EE015	IRQ enable register	IER	R/W	H'00
H'EE016	IRQ status register	ISR	R/(W)*[2]	H'00
H'EE018	Interrupt priority register A	IPRA	R/W	H'00
H'EE019	Interrupt priority register B	IPRB	R/W	H'00

Notes: 1. Lower 20 bits of the address in advanced mode.
2. Only 0 can be written, to clear flags.

5.2 Register Descriptions

5.2.1 System Control Register (SYSCR)

SYSCR is an 8-bit readable/writable register that controls software standby mode, selects the action of the UI bit in CCR, selects the NMI edge, and enables or disables the on-chip RAM.

Only bits 3 and 2 are described here. For the other bits, see section 3.3, System Control Register (SYSCR).

SYSCR is initialized to H'09 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bit	7	6	5	4	3	2	1	0
	SSBY	STS2	STS1	STS0	UE	NMIEG	SSOE	RAME
Initial value	0	0	0	0	1	0	0	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

RAM enable

Software standby output port enable

NMI edge select
Selects the NMI input edge

Standby timer select 2 to 0

Software standby

User bit enable
Selects whether to use the UI bit in CCR as a user bit or interrupt mask bit

Bit 3—User Bit Enable (UE): Selects whether to use the UI bit in CCR as a user bit or an interrupt mask bit.

Bit 3 UE	Description	
0	UI bit in CCR is used as interrupt mask bit	
1	UI bit in CCR is used as user bit	(Initial value)

Bit 2—NMI Edge Select (NMIEG): Selects the NMI input edge.

Bit 2 NMIEG	Description	
0	Interrupt is requested at falling edge of NMI input	(Initial value)
1	Interrupt is requested at rising edge of NMI input	

5.2.2 Interrupt Priority Registers A and B (IPRA, IPRB)

IPRA and IPRB are 8-bit readable/writable registers that control interrupt priority.

Interrupt Priority Register A (IPRA): IPRA is an 8-bit readable/writable register in which interrupt priority levels can be set.

Bit	7	6	5	4	3	2	1	0
	IPRA7	IPRA6	IPRA5	IPRA4	IPRA3	IPRA2	IPRA1	IPRA0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Priority level A0
Selects the priority level of 16-bit timer channel 2 interrupt requests

Priority level A1
Selects the priority level of 16-bit timer channel 1 interrupt requests

Priority level A2
Selects the priority level of 16-bit timer channel 0 interrupt requests

Priority level A3
Selects the priority level of WDT, DRAM interface, and A/D converter interrupt requests

Priority level A4
Selects the priority level of IRQ_4 and IRQ_5 interrupt requests

Priority level A5
Selects the priority level of IRQ_2 and IRQ_3 interrupt requests

Priority level A6
Selects the priority level of IRQ_1 interrupt requests

Priority level A7
Selects the priority level of IRQ_0 interrupt requests

IPRA is initialized to H'00 by a reset and in hardware standby mode.

Bit 7—Priority Level A7 (IPRA7): Selects the priority level of IRQ_0 interrupt requests.

Bit 7 IPRA7	Description	
0	IRQ_0 interrupt requests have priority level 0 (low priority)	(Initial value)
1	IRQ_0 interrupt requests have priority level 1 (high priority)	

Bit 6—Priority Level A6 (IPRA6): Selects the priority level of IRQ_1 interrupt requests.

Bit 6 IPRA6	Description	
0	IRQ_1 interrupt requests have priority level 0 (low priority)	(Initial value)
1	IRQ_1 interrupt requests have priority level 1 (high priority)	

Bit 5—Priority Level A5 (IPRA5): Selects the priority level of IRQ_2 and IRQ_3 interrupt requests.

Bit 5 IPRA5	Description	
0	IRQ_2 and IRQ_3 interrupt requests have priority level 0 (low priority)	(Initial value)
1	IRQ_2 and IRQ_3 interrupt requests have priority level 1 (high priority)	

Bit 4—Priority Level A4 (IPRA4): Selects the priority level of IRQ_4 and IRQ_5 interrupt requests.

Bit 4 IPRA4	Description	
0	IRQ_4 and IRQ_5 interrupt requests have priority level 0 (low priority)	(Initial value)
1	IRQ_4 and IRQ_5 interrupt requests have priority level 1 (high priority)	

Bit 3—Priority Level A3 (IPRA3): Selects the priority level of WDT, DRAM interface, and A/D converter interrupt requests.

Bit 3 IPRA3	Description
0	WDT, DRAM interface, and A/D converter interrupt requests have priority level 0 (low priority) (Initial value)
1	WDT, DRAM interface, and A/D converter interrupt requests have priority level 1 (high priority)

Bit 2—Priority Level A2 (IPRA2): Selects the priority level of 16-bit timer channel 0 interrupt requests.

Bit 2 IPRA2	Description
0	16-bit timer channel 0 interrupt requests have priority level 0 (low priority) (Initial value)
1	16-bit timer channel 0 interrupt requests have priority level 1 (high priority)

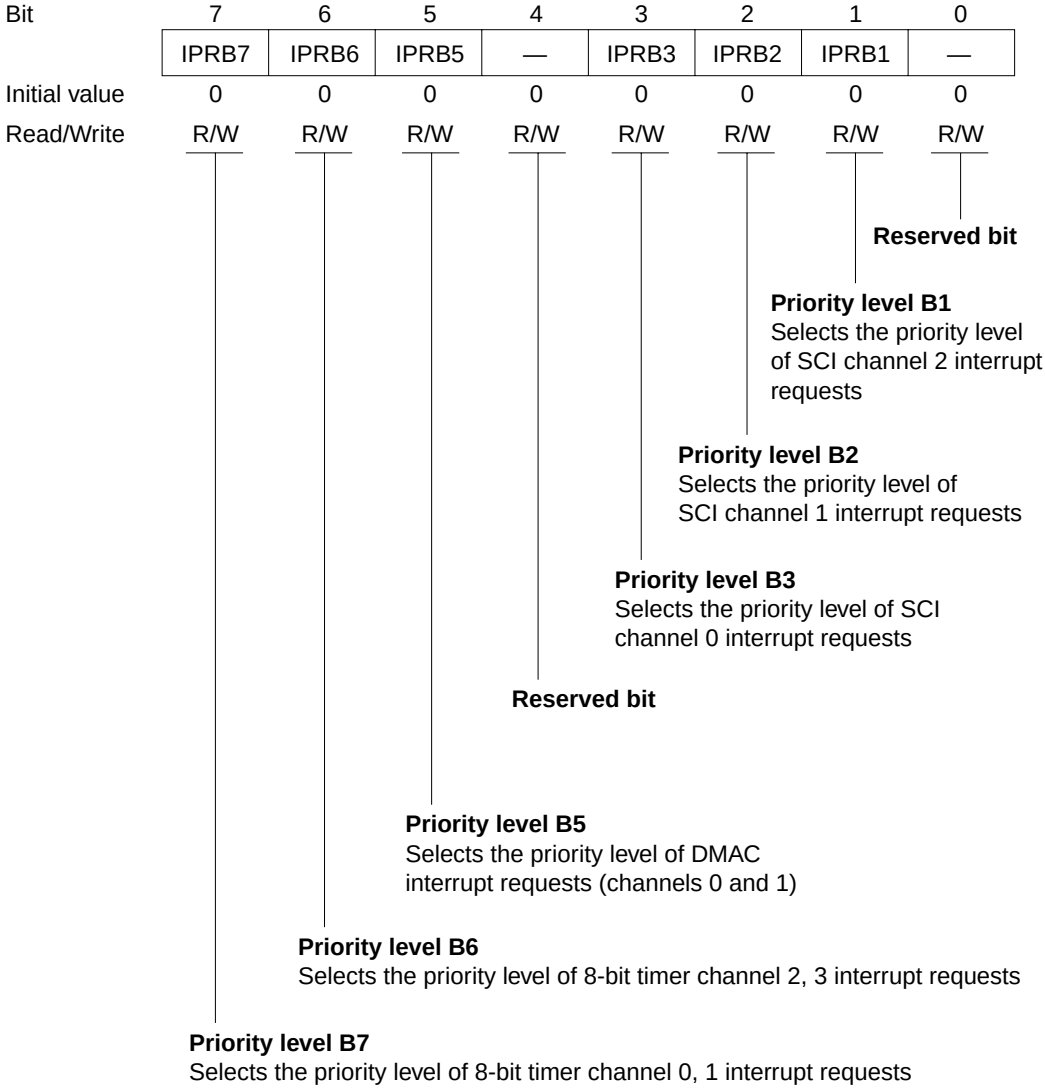
Bit 1—Priority Level A1 (IPRA1): Selects the priority level of 16-bit timer channel 1 interrupt requests.

Bit 1 IPRA1	Description
0	16-bit timer channel 1 interrupt requests have priority level 0 (low priority) (Initial value)
1	16-bit timer channel 1 interrupt requests have priority level 1 (high priority)

Bit 0—Priority Level A0 (IPRA0): Selects the priority level of 16-bit timer channel 2 interrupt requests.

Bit 0 IPRA0	Description
0	16-bit timer channel 2 interrupt requests have priority level 0 (low priority) (Initial value)
1	16-bit timer channel 2 interrupt requests have priority level 1 (high priority)

Interrupt Priority Register B (IPRB): IPRB is an 8-bit readable/writable register in which interrupt priority levels can be set.



IPRB is initialized to H'00 by a reset and in hardware standby mode.

Bit 7—Priority Level B7 (IPRB7): Selects the priority level of 8-bit timer channel 0, 1 interrupt requests.

Bit 7 IPRB7	Description
0	8-bit timer channel 0, 1 interrupt requests have priority level 0 (low priority)(Initial value)
1	8-bit timer channel 0, 1 interrupt requests have priority level 1 (high priority)

Bit 6—Priority Level B6 (IPRB6): Selects the priority level of 8-bit timer channel 2, 3 interrupt requests.

Bit 6 IPRB6	Description
0	8-bit timer channel 2, 3 interrupt requests have priority level 0 (low priority)(Initial value)
1	8-bit timer channel 2, 3 interrupt requests have priority level 1 (high priority)

Bit 5—Priority Level B5 (IPRB5): Selects the priority level of DMAC interrupt requests (channels 0 and 1).

Bit 5 IPRB5	Description
0	DMAC interrupt requests (channels 0 and 1) have priority level 0 (low priority) (Initial value)
1	DMAC interrupt requests (channels 0 and 1) have priority level 1 (high priority)

Bit 4—Reserved: This bit can be written and read, but it does not affect interrupt priority.

Bit 3—Priority Level B3 (IPRB3): Selects the priority level of SCI channel 0 interrupt requests.

Bit 3 IPRB3	Description	
0	SCI channel 0 interrupt requests have priority level 0 (low priority)	(Initial value)
1	SCI channel 0 interrupt requests have priority level 1 (high priority)	

Bit 2—Priority Level B2 (IPRB2): Selects the priority level of SCI channel 1 interrupt requests.

Bit 2 IPRB2	Description	
0	SCI channel 1 interrupt requests have priority level 0 (low priority)	(Initial value)
1	SCI channel 1 interrupt requests have priority level 1 (high priority)	

Bit 1—Priority Level B1 (IPRB1): Selects the priority level of SCI channel 2 interrupt requests.

Bit 1 IPRB1	Description	
0	SCI channel 2 interrupt requests have priority level 0 (low priority)	(Initial value)
1	SCI channel 2 interrupt requests have priority level 1 (high priority)	

Bit 0—Reserved: This bit can be written and read, but it does not affect interrupt priority.

5.2.3 IRQ Status Register (ISR)

ISR is an 8-bit readable/writable register that indicates the status of IRQ_0 to IRQ_5 interrupt requests.

Bit	7	6	5	4	3	2	1	0
	—	—	IRQ5F	IRQ4F	IRQ3F	IRQ2F	IRQ1F	IRQ0F
Initial value	0	0	0	0	0	0	0	0
Read/Write	—	—	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/(W)*

Reserved bits

IRQ_5 to IRQ_0 flags
These bits indicate IRQ_5 to IRQ_0 interrupt request status

Note: * Only 0 can be written, to clear flags.

ISR is initialized to H'00 by a reset and in hardware standby mode.

Bits 7 and 6—Reserved: These bits can not be modified and are always read as 0.

Bits 5 to 0—IRQ_5 to IRQ_0 Flags (IRQ5F to IRQ0F): These bits indicate the status of IRQ_5 to IRQ_0 interrupt requests.

Bits 5 to 0 IRQ5F to IRQ0F	Description
0	[Clearing conditions] (Initial value) 0 is written in IRQnF after reading the IRQnF flag when IRQnF = 1. IRQnSC = 0, $\overline{IRQn}$ input is high, and interrupt exception handling is carried out. IRQnSC = 1 and IRQn interrupt exception handling is carried out.
1	[Setting conditions] IRQnSC = 0 and $\overline{IRQn}$ input is low. IRQnSC = 1 and $\overline{IRQn}$ input changes from high to low.

Note: n = 5 to 0

5.2.4 IRQ Enable Register (IER)

IER is an 8-bit readable/writable register that enables or disables IRQ_5 to IRQ_0 interrupt requests.

Bit	7	6	5	4	3	2	1	0
	—	—	IRQ5E	IRQ4E	IRQ3E	IRQ2E	IRQ1E	IRQ0E
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Reserved bits

IRQ_5 to IRQ_0 enable
These bits enable or disable IRQ_5 to IRQ_0 interrupt requests

IER is initialized to H'00 by a reset and in hardware standby mode.

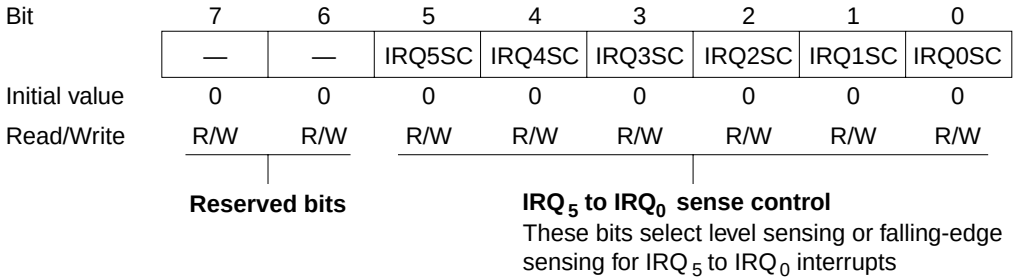
Bits 7 and 6—Reserved: These bits can be written and read, but they do not enable or disable interrupts.

Bits 5 to 0—IRQ_5 to IRQ_0 Enable (IRQ5E to IRQ0E): These bits enable or disable IRQ_5 to IRQ_0 interrupt requests.

Bits 5 to 0 IRQ5E to IRQ0E	Description	
0	IRQ_5 to IRQ_0 interrupt requests are disabled	(Initial value)
1	IRQ_5 to IRQ_0 interrupt requests are enabled	

5.2.5 IRQ Sense Control Register (ISCR)

ISCR is an 8-bit readable/writable register that selects level sensing or falling-edge sensing of the inputs at pins $\overline{IRQ}_5$ to $\overline{IRQ}_0$.



ISCR is initialized to H'00 by a reset and in hardware standby mode.

Bits 7 and 6—Reserved: These bits can be written and read, but they do not select level or falling-edge sensing.

Bits 5 to 0—IRQ_5 to IRQ_0 Sense Control (IRQ5SC to IRQ0SC): These bits select whether interrupts IRQ_5 to IRQ_0 are requested by level sensing of pins $\overline{IRQ}_5$ to $\overline{IRQ}_0$, or by falling-edge sensing.

Bits 5 to 0 IRQ5SC to IRQ0SC	Description	
0	Interrupts are requested when $\overline{IRQ}_5$ to $\overline{IRQ}_0$ inputs are low	(Initial value)
1	Interrupts are requested by falling-edge input at $\overline{IRQ}_5$ to $\overline{IRQ}_0$	

5.3 Interrupt Sources

The interrupt sources include external interrupts (NMI, IRQ_0 to IRQ_5) and 36 internal interrupts.

5.3.1 External Interrupts

There are seven external interrupts: NMI and IRQ_0 to IRQ_5. Of these, NMI, IRQ_0, IRQ_1, and IRQ_2 can be used to exit software standby mode.

NMI: NMI is the highest-priority interrupt and is always accepted, regardless of the states of the I and UI bits in CCR*. The NMIEG bit in SYSCR selects whether an interrupt is requested by the rising or falling edge of the input at the NMI pin. NMI interrupt exception handling has vector number 7.

Note: * NMI input is sometimes disabled when flash memory is being programmed or erased. For details see section 18.4.5, Flash Vector Address Control Register (FVACR).

IRQ_0 to IRQ_5 Interrupts: These interrupts are requested by input signals at pins $\overline{IRQ_0}$ to $\overline{IRQ_5}$. The IRQ_0 to IRQ_5 interrupts have the following features.

- ISCR settings can select whether an interrupt is requested by the low level of the input at pins $\overline{IRQ_0}$ to $\overline{IRQ_5}$, or by the falling edge.
- IER settings can enable or disable the IRQ_0 to IRQ_5 interrupts. Interrupt priority levels can be assigned by four bits in IPRA (IPRA7 to IPRA4).
- The status of IRQ_0 to IRQ_5 interrupt requests is indicated in ISR. The ISR flags can be cleared to 0 by software.

Figure 5.2 shows a block diagram of interrupts IRQ_0 to IRQ_5.

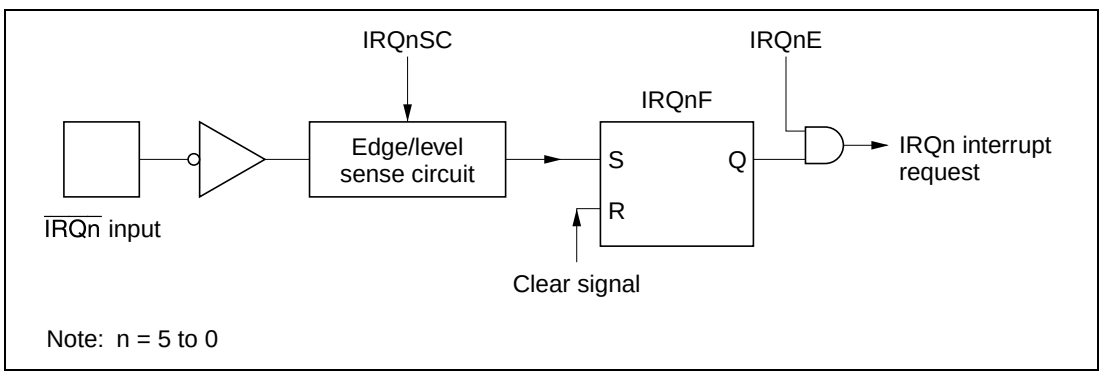


Figure 5.2 Block Diagram of Interrupts IRQ_0 to IRQ_5

Figure 5.3 shows the timing of the setting of the interrupt flags (IRQnF).

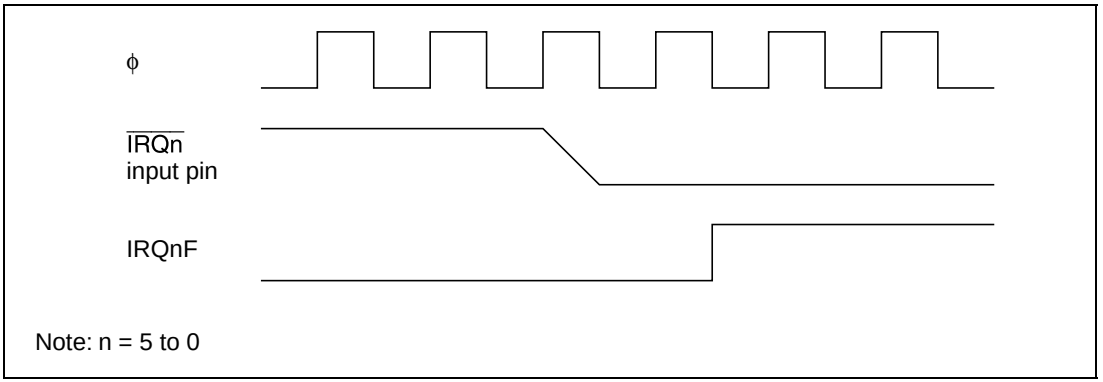


Figure 5.3 Timing of Setting of IRQnF

Interrupts IRQ_0 to IRQ_5 have vector numbers 12 to 17. These interrupts are detected regardless of whether the corresponding pin is set for input or output. When using a pin for external interrupt input, clear its DDR bit to 0 and do not use the pin for chip select output, refresh output, SCI input/output, or A/D external trigger input.

5.3.2 Internal Interrupts

Thirty-Six internal interrupts are requested from the on-chip supporting modules.

- Each on-chip supporting module has status flags for indicating interrupt status, and enable bits for enabling or disabling interrupts.
- Interrupt priority levels can be assigned in IPRA and IPRB.
- 16-bit timer, SCI, and A/D converter interrupt requests can activate the DMAC, in which case no interrupt request is sent to the interrupt controller, and the I and UI bits are disregarded.

5.3.3 Interrupt Vector Table

Table 5.3 lists the interrupt sources, their vector addresses, and their default priority order. In the default priority order, smaller vector numbers have higher priority. The priority of interrupts other than NMI can be changed in IPRA and IPRB. The priority order after a reset is the default order shown in table 5.3.

Table 5.3 Interrupt Sources, Vector Addresses, and Priority

Interrupt Source	Origin	Vector Number	Vector Address*1		IPR	Priority
			Advanced Mode	Normal Mode*2		
NMI	External pins	7	H'001C to H'001F	H'000E to H'000F	—	High
IRQ_0		12	H'0030 to H'0033	H'0018 to H'0019	IPRA7	
IRQ_1		13	H'0034 to H0037	H'001A to H'001B	IPRA6	
IRQ_2		14	H'0038 to H'003B	H'001C to H'001D	IPRA5	
IRQ_3		15	H'003C to H'003F	H'001E to H'001F		
IRQ_4		16	H'0040 to H'0043	H'0020 to H'0021	IPRA4	
IRQ_5		17	H'0044 to H'0047	H'0022 to H'0023		
Reserved	—	18	H'0048 to H'004B	H'0024 to H'0025		
		19	H'004C to H'004F	H'0026 to H'0027		
WOVI (interval timer)	Watchdog timer	20	H'0050 to H'0053	H'0028 to H'0029	IPRA3	
CMI (compare match)	DRAM interface	21	H'0054 to H'0057	H'002A to H'002B		
Reserved	—	22	H'0058 to H'005B	H'002C to H'002D		
ADI (A/D end)	A/D	23	H'005C to H'005F	H'002E to H'002F		
IMIA0 (compare match/ input capture A0)	16-bit timer channel 0	24	H'0060 to H'0063	H'0030 to H'0031	IPRA2	
IMIB0 (compare match/ input capture B0)		25	H'0064 to H'0067	H'0032 to H'0033		
OVI0 (overflow 0)		26	H'0068 to H'006B	H'0034 to H'0035		
Reserved	—	27	H'006C to H'006F	H'0036 to H'0037		
IMIA1 (compare match/ inputcapture A1)	16-bit timer channel 1	28	H'0070 to H'0073	H'0038 to H'0039	IPRA1	
IMIB1 (compare match/ input capture B1)		29	H'0074 to H'0077	H'003A to H'003B		
OVI1 (overflow 1)		30	H'0078 to H'007B	H'003C to H'003D		
Reserved	—	31	H'007C to H'007F	H'003E to H'003F		Low

Interrupt Source	Origin	Vector Number	Vector Address*1		IPR	Priority
			Advanced Mode	Normal Mode*2		
IMIA2 (compare match/ input capture A2)	16-bit timer channel 2	32	H'0080 to H'0083	H'0040 to H'0041	IPRA0	High
IMIB2 (compare match/ input capture B2)		33	H'0084 to H'0087	H'0042 to H'0043		
OVI2 (overflow 2)		34	H'0088 to H'008B	H'0044 to H'0045		
Reserved	—	35	H'008C to H'008F	H'0046 to H'0047		
CMIA0 (compare match A0)	8-bit timer channel 0/1	36	H'0090 to H'0093	H'0048 to H'0049	IPRB7	
CMIB0 (compare match B0)		37	H'0094 to H'0097	H'004A to H'004B		
CMIA1/CMIB1 (compare match A1/B1)		38	H'0098 to H'009B	H'004C to H'004D		
TOVI0/TOVI1 (overflow 0/1)		39	H'009C to H'009F	H'004E to H'004F		
CMIA2 (compare match A2)	8-bit timer channel 2/3	40	H'00A0 to H'00A3	H'0050 to H'0051	IPRB6	
CMIB2 (compare match B2)		41	H'00A4 to H'00A7	H'0052 to H'0053		
CMIA3/CMIB3 (compare match A3/B3)		42	H'00A8 to H'00AB	H'0054 to H'0055		
TOVI2/TOVI3 (overflow 2/3)		43	H'00AC to H'00AF	H'0056 to H'0057		
DEND0A	DMAC	44	H'00B0 to H'00B3	H'0058 to H'0059	IPRB5	
DEND0B		45	H'00B4 to H'00B7	H'005A to H'005B		
DEND1A		46	H'00B8 to H'00BB	H'005C to H'005D		
DEND1B		47	H'00BC to H'00BF	H'005E to H'005F		
Reserved	—	48	H'00C0 to H'00C3	H'0060 to H'0061	—	
		49	H'00C4 to H'00C7	H'0062 to H'0063		
		50	H'00C8 to H'00CB	H'0064 to H'0065		
		51	H'00CC to H'00CF	H'0066 to H'0067		Low

Interrupt Source	Origin	Vector Number	Vector Address*1		IPR	Priority
			Advanced Mode	Normal Mode*2		
ERI0 (receive error 0)	SCI channel 0	52	H'00D0 to H'00D3	H'0068 to H'0069	IPRB3	High
RXI0 (receive data full 0)		53	H'00D4 to H'00D7	H'006A to H'006B		
TXI0 (transmit data empty 0)		54	H'00D8 to H'00DB	H'006C to H'006D		
TEI0 (transmit end 0)		55	H'00DC to H'00DF	H'006E to H'006F		
ERI1 (receive error 1)	SCI channel 1	56	H'00E0 to H'00E3	H'0070 to H'0071	IPRB2	
RXI1 (receive data full 1)		57	H'00E4 to H'00E7	H'0072 to H'0073		
TXI1 (transmit data empty 1)		58	H'00E8 to H'00EB	H'0074 to H'0075		
TEI1 (transmit end 1)		59	H'00EC to H'00EF	H'0076 to H'0077		
ERI2 (receive error 2)	SCI channel 2	60	H'00F0 to H'00F3	H'0078 to H'0079	IPRB1	
RXI2 (receive data full 2)		61	H'00F4 to H'00F7	H'007A to H'007B		
TXI2 (transmit data empty 2)		62	H'00F8 to H'00FB	H'007C to H'007D		
TEI2 (transmit end 2)		63	H'00FC to H'00FF	H'007E to H'007F		Low

Notes: 1. Lower 16 bits of the address.
2. Cannot be selected in H8/3069R.

5.4 Interrupt Operation

5.4.1 Interrupt Handling Process

The H8/3069R handles interrupts differently depending on the setting of the UE bit. When UE = 1, interrupts are controlled by the I bit. When UE = 0, interrupts are controlled by the I and UI bits. Table 5.4 indicates how interrupts are handled for all setting combinations of the UE, I, and UI bits.

NMI interrupts are always accepted except in the reset and hardware standby states*. IRQ interrupts and interrupts from the on-chip supporting modules have their own enable bits. Interrupt requests are ignored when the enable bits are cleared to 0.

Note: * NMI input is sometimes disabled. For details see section 18.4.5, Flash Vector Address Control Register (FVACR).

Table 5.4 UE, I, and UI Bit Settings and Interrupt Handling

SYSCR	CCR		
UE	**I**	**UI**	**Description**
1	0	—	All interrupts are accepted. Interrupts with priority level 1 have higher priority.
	1	—	No interrupts are accepted except NMI.
0	0	—	All interrupts are accepted. Interrupts with priority level 1 have higher priority.
	1	0	NMI and interrupts with priority level 1 are accepted.
		1	No interrupts are accepted except NMI.

UE = 1: Interrupts IRQ_0 to IRQ_5 and interrupts from the on-chip supporting modules can all be masked by the I bit in the CPU's CCR. Interrupts are masked when the I bit is set to 1, and unmasked when the I bit is cleared to 0. Interrupts with priority level 1 have higher priority. Figure 5.4 is a flowchart showing how interrupts are accepted when UE = 1.

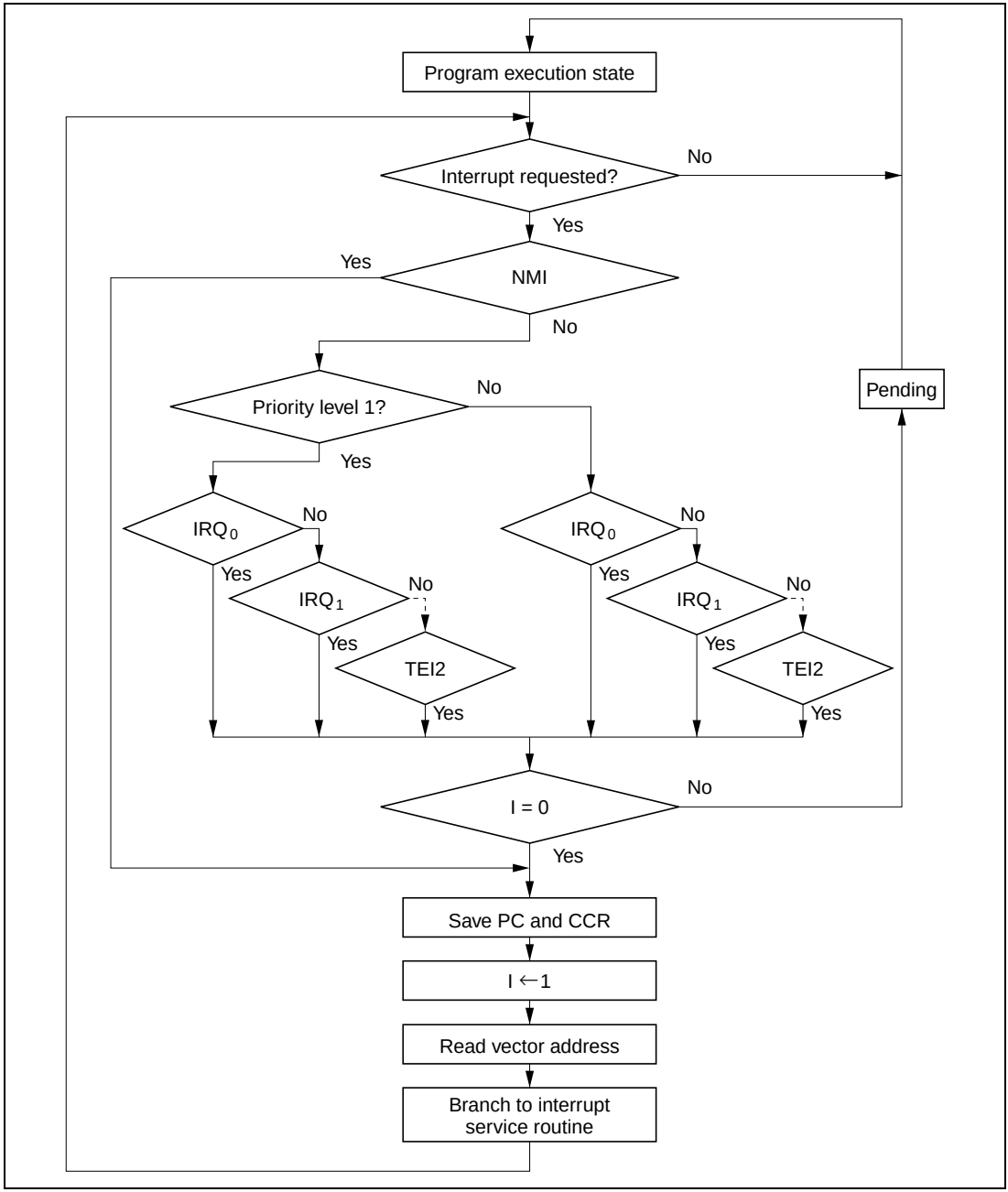


Figure 5.4 Process Up to Interrupt Acceptance when UE = 1

- If an interrupt condition occurs and the corresponding interrupt enable bit is set to 1, an interrupt request is sent to the interrupt controller.
- When the interrupt controller receives one or more interrupt requests, it selects the highest-priority request, following the IPR interrupt priority settings, and holds other requests pending. If two or more interrupts with the same IPR setting are requested simultaneously, the interrupt controller follows the priority order shown in table 5.3.
- The interrupt controller checks the I bit. If the I bit is cleared to 0, the selected interrupt request is accepted. If the I bit is set to 1, only NMI is accepted; other interrupt requests are held pending.
- When an interrupt request is accepted, interrupt exception handling starts after execution of the current instruction has been completed.
- In interrupt exception handling, PC and CCR are saved to the stack area. The PC value that is saved indicates the address of the first instruction that will be executed after the return from the interrupt service routine.
- Next the I bit is set to 1 in CCR, masking all interrupts except NMI.
- The vector address of the accepted interrupt is generated, and the interrupt service routine starts executing from the address indicated by the contents of the vector address.

UE = 0: The I and UI bits in the CPU's CCR and the IPR bits enable three-level masking of IRQ_0 to IRQ_5 interrupts and interrupts from the on-chip supporting modules.

- Interrupt requests with priority level 0 are masked when the I bit is set to 1, and are unmasked when the I bit is cleared to 0.
- Interrupt requests with priority level 1 are masked when the I and UI bits are both set to 1, and are unmasked when either the I bit or the UI bit is cleared to 0.

  For example, if the interrupt enable bits of all interrupt requests are set to 1, IPRA is set to H'20, and IPRB is set to H'00 (giving IRQ_2 and IRQ_3 interrupt requests priority over other interrupts), interrupts are masked as follows:

  a. If I = 0, all interrupts are unmasked (priority order: NMI > IRQ_2 > IRQ_3 >IRQ_0 …).
  b. If I = 1 and UI = 0, only NMI, IRQ_2, and IRQ_3 are unmasked.
  c. If I = 1 and UI = 1, all interrupts are masked except NMI.

Figure 5.5 shows the transitions among the above states.

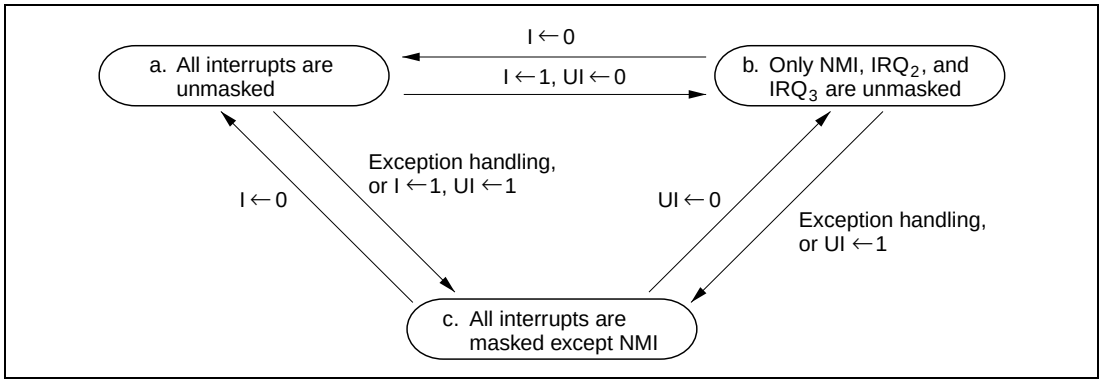


Figure 5.5 Interrupt Masking State Transitions (Example)

Figure 5.6 is a flowchart showing how interrupts are accepted when UE = 0.

- If an interrupt condition occurs and the corresponding interrupt enable bit is set to 1, an interrupt request is sent to the interrupt controller.
- When the interrupt controller receives one or more interrupt requests, it selects the highest-priority request, following the IPR interrupt priority settings, and holds other requests pending. If two or more interrupts with the same IPR setting are requested simultaneously, the interrupt controller follows the priority order shown in table 5.3.
- The interrupt controller checks the I bit. If the I bit is cleared to 0, the selected interrupt request is accepted regardless of its IPR setting, and regardless of the UI bit. If the I bit is set to 1 and the UI bit is cleared to 0, only NMI and interrupts with priority level 1 are accepted; interrupt requests with priority level 0 are held pending. If the I bit and UI bit are both set to 1, only NMI is accepted; all other interrupt requests are held pending.
- When an interrupt request is accepted, interrupt exception handling starts after execution of the current instruction has been completed.
- In interrupt exception handling, PC and CCR are saved to the stack area. The PC value that is saved indicates the address of the first instruction that will be executed after the return from the interrupt service routine.
- The I and UI bits are set to 1 in CCR, masking all interrupts except NMI.
- The vector address of the accepted interrupt is generated, and the interrupt service routine starts executing from the address indicated by the contents of the vector address.

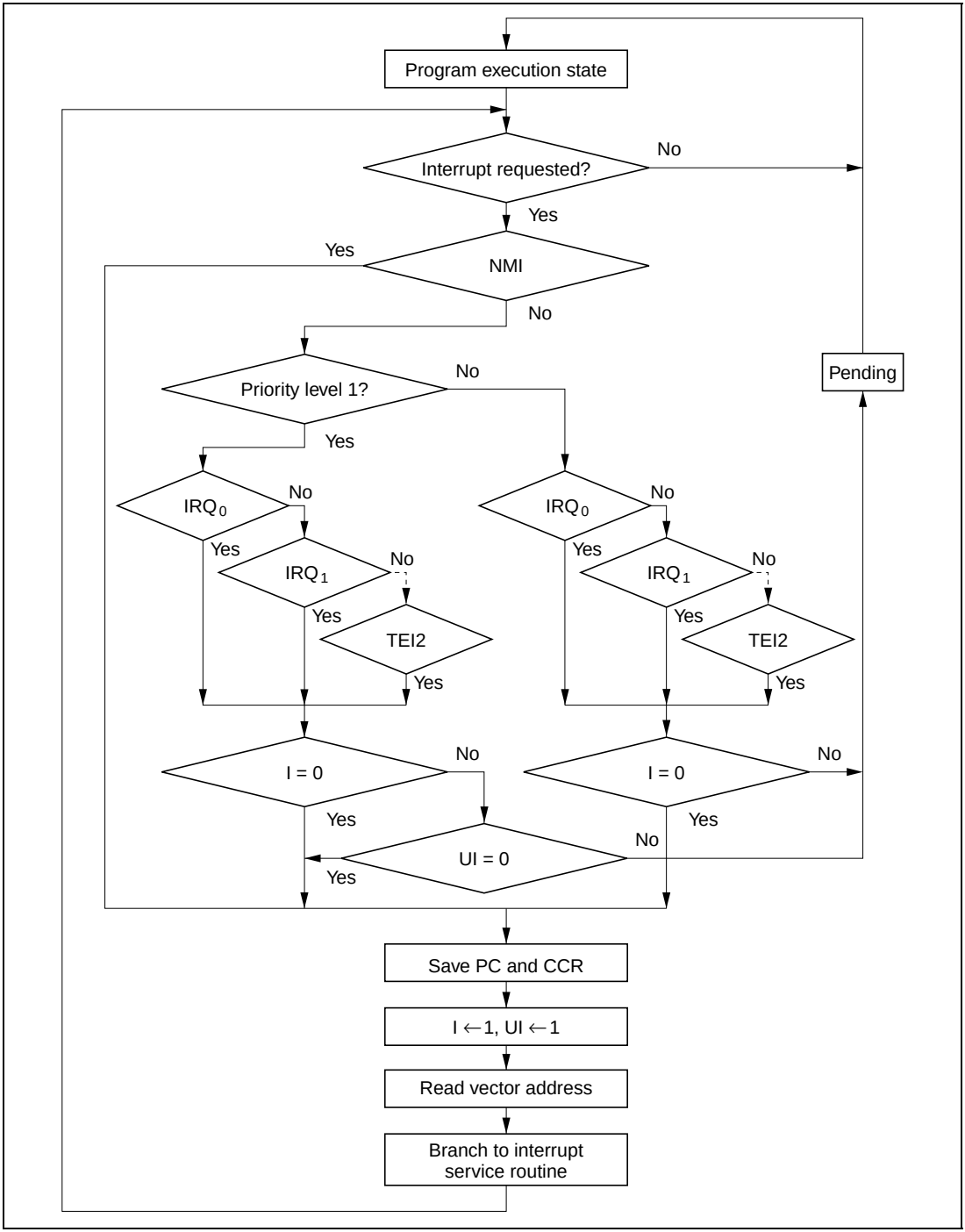


Figure 5.6 Process Up to Interrupt Acceptance when UE = 0

5.4.2 Interrupt Sequence

Figure 5.7 shows the interrupt sequence in mode 2 when the program code and stack are in an external memory area accessed in two states via a 16-bit bus.

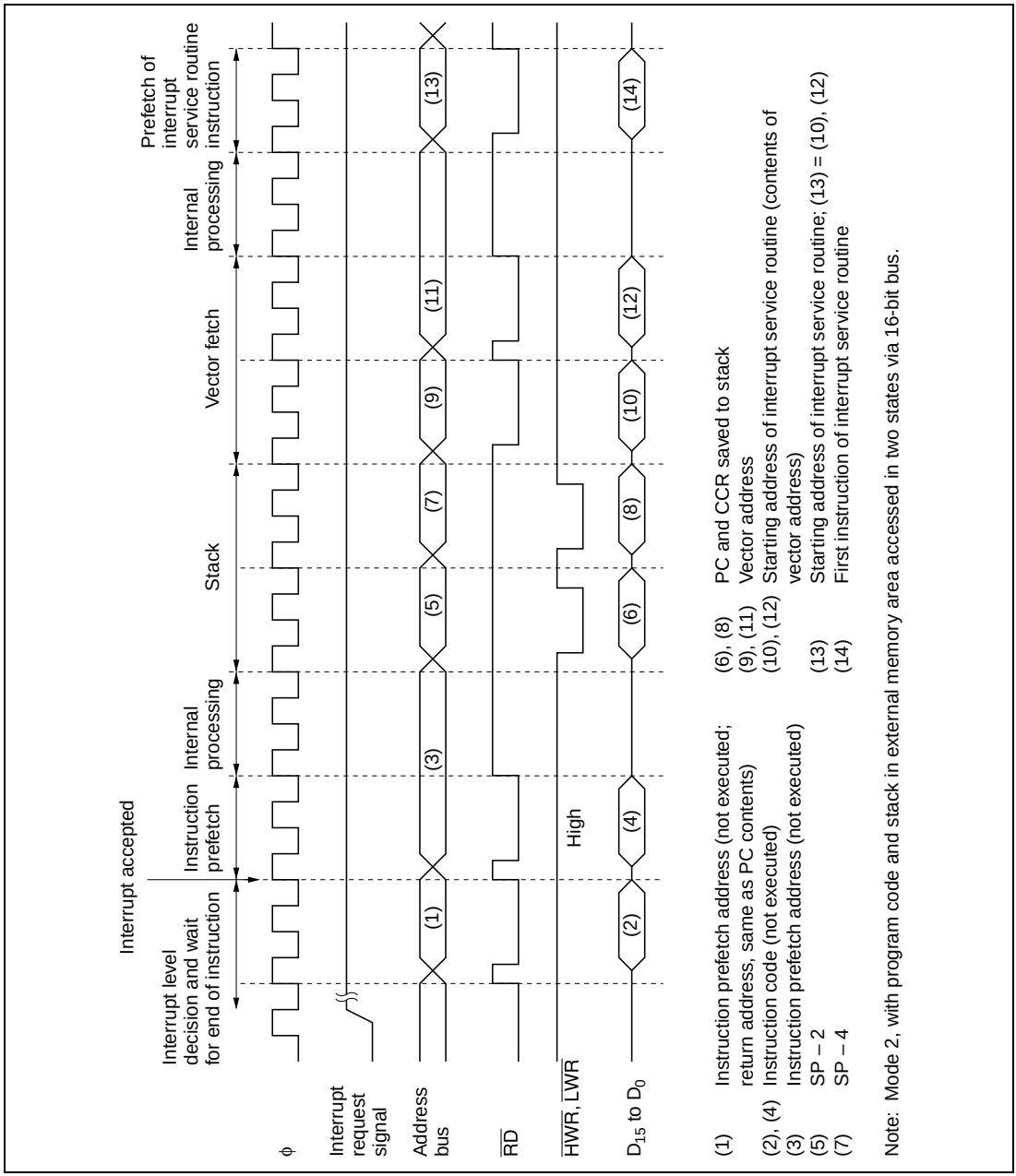


Figure 5.7 Interrupt Sequence

5.4.3 Interrupt Response Time

Table 5.5 indicates the interrupt response time from the occurrence of an interrupt request until the first instruction of the interrupt service routine is executed.

Table 5.5 Interrupt Response Time

			External Memory			
			8-Bit Bus		16-Bit Bus	
No.	Item	On-Chip Memory	2 States	3 States	2 States	3 States
1	Interrupt priority decision	2*[1]	2*[1]	2*[1]	2*[1]	2*[1]
2	Maximum number of states until end of current instruction	1 to 23*[5]	1 to 27*[5] *[6]	1 to 41*[4] *[6]	1 to 23*[5]	1 to 25*[4] *[5]
3	Saving PC and CCR to stack	4	8	12*[4]	4	6*[4]
4	Vector fetch	4	8	12*[4]	4	6*[4]
5	Instruction prefetch*[2]	4	8	12*[4]	4	6*[4]
6	Internal processing*[3]	4	4	4	4	4
Total		19 to 41	31 to 57	43 to 83	19 to 41	25 to 49

Notes:
1. 1 state for internal interrupts.
2. Prefetch after the interrupt is accepted and prefetch of the first instruction in the interrupt service routine.
3. Internal processing after the interrupt is accepted and internal processing after vector fetch.
4. The number of states increases if wait states are inserted in external memory access.
5. The examples of DIVXS.W Rs,ERd, MULXS.W Rs,ERd.
6. The examples of MOV.L @(d:24,ERs), ERd, MOV.L ERs,@(d:24,ERd).

5.5 Usage Notes

5.5.1 Contention between Interrupt and Interrupt-Disabling Instruction

When an instruction clears an interrupt enable bit to 0 to disable the interrupt, the interrupt is not disabled until after execution of the instruction is completed. If an interrupt occurs while a BCLR, MOV, or other instruction is being executed to clear its interrupt enable bit to 0, at the instant when execution of the instruction ends the interrupt is still enabled, so its interrupt exception handling is carried out. If a higher-priority interrupt is also requested, however, interrupt exception handling for the higher-priority interrupt is carried out, and the lower-priority interrupt is ignored. This also applies to the clearing of an interrupt flag to 0.

Figure 5.8 shows an example in which an IMIEA bit is cleared to 0 in the 16-bit timer's TISRA register.

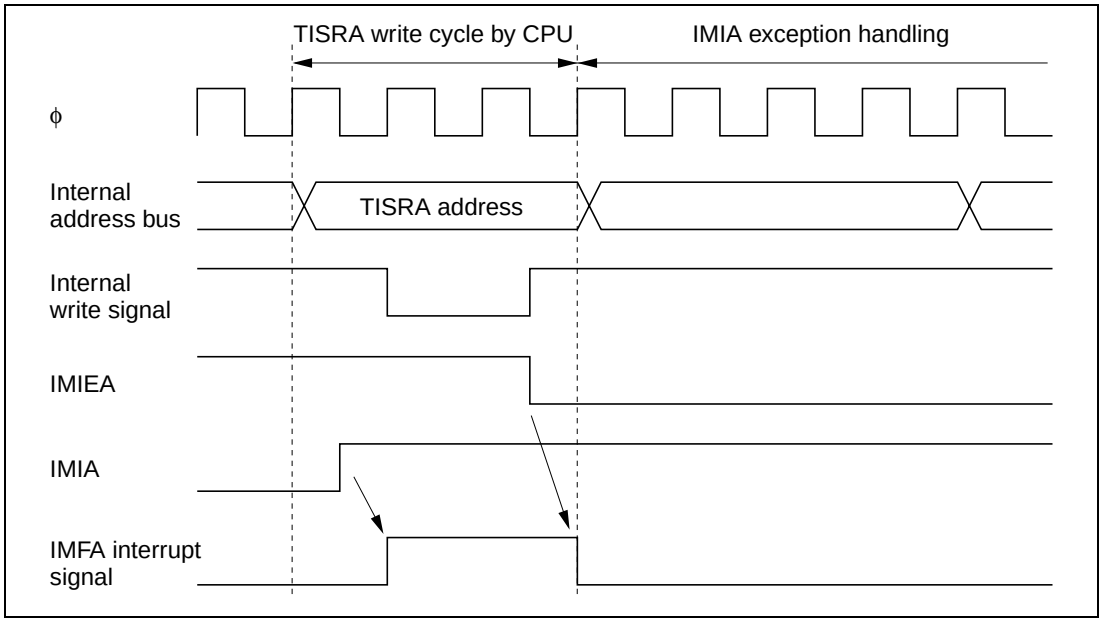


Figure 5.8 Contention between Interrupt and Interrupt-Disabling Instruction

This type of contention will not occur if the interrupt is masked when the interrupt enable bit or flag is cleared to 0.

5.5.2 Instructions that Inhibit Interrupts

The LDC, ANDC, ORC, and XORC instructions inhibit interrupts. When an interrupt occurs, after determining the interrupt priority, the interrupt controller requests a CPU interrupt. If the CPU is currently executing one of these interrupt-inhibiting instructions, however, when the instruction is completed the CPU always continues by executing the next instruction.

5.5.3 Interrupts during EEPMOV Instruction Execution

The EEPMOV.B and EEPMOV.W instructions differ in their reaction to interrupt requests.

When the EEPMOV.B instruction is executing a transfer, no interrupts are accepted until the transfer is completed, not even NMI.

When the EEPMOV.W instruction is executing a transfer, interrupt requests other than NMI are not accepted until the transfer is completed. If NMI is requested, NMI exception handling starts at a transfer cycle boundary. The PC value saved on the stack is the address of the next instruction. Programs should be coded as follows to allow for NMI interrupts during EEPMOV.W execution:

```
L1: EEPMOV.W
    MOV.W R4,R4
    BNE  L1
```

Section 6 Bus Controller

6.1 Overview

The H8/3069R has an on-chip bus controller (BSC) that manages the external address space divided into eight areas. The bus specifications, such as bus width and number of access states, can be set independently for each area, enabling multiple memories to be connected easily.

The bus controller also has a bus arbitration function that controls the operation of the internal bus masters-the CPU, DMA controller (DMAC), and DRAM interface and can release the bus to an external device.

6.1.1 Features

The features of the bus controller are listed below.

- Manages external address space in area units
  - Manages the external space as eight areas (0 to 7) of 128 kbytes in 1-Mbyte modes, or 2 Mbytes in 16-Mbyte modes
  - Bus specifications can be set independently for each area
  - DRAM/burst ROM interfaces can be set
- Basic bus interface
  - Chip select ($\overline{CS}_0$ to $\overline{CS}_7$) can be output for areas 0 to 7
  - 8-bit access or 16-bit access can be selected for each area
  - Two-state access or three-state access can be selected for each area
  - Program wait states can be inserted for each area
  - Pin wait insertion capability is provided
- DRAM interface
  - DRAM interface can be set for areas 2 to 5
  - Row address/column address multiplexed output (8/9/10 bits)
  - 2-CAS byte access mode
  - Burst operation (fast page mode)
  - T_p cycle insertion to secure RAS precharging time
  - Choice of CAS-before-RAS refreshing or self-refreshing
- Burst ROM interface
  - Burst ROM interface can be set for area 0
  - Selection of two- or three-state burst access

- Idle cycle insertion
  - An idle cycle can be inserted in case of an external read cycle between different areas
  - An idle cycle can be inserted when an external read cycle is immediately followed by an external write cycle
- Bus arbitration function
  - A built-in bus arbiter grants the bus right to the CPU, DMAC, DRAM interface, or an external bus master
- Other features
  - Refresh counter (refresh timer) can be used as interval timer
  - Choice of two address update modes

6.1.2 Block Diagram

Figure 6.1 shows a block diagram of the bus controller.

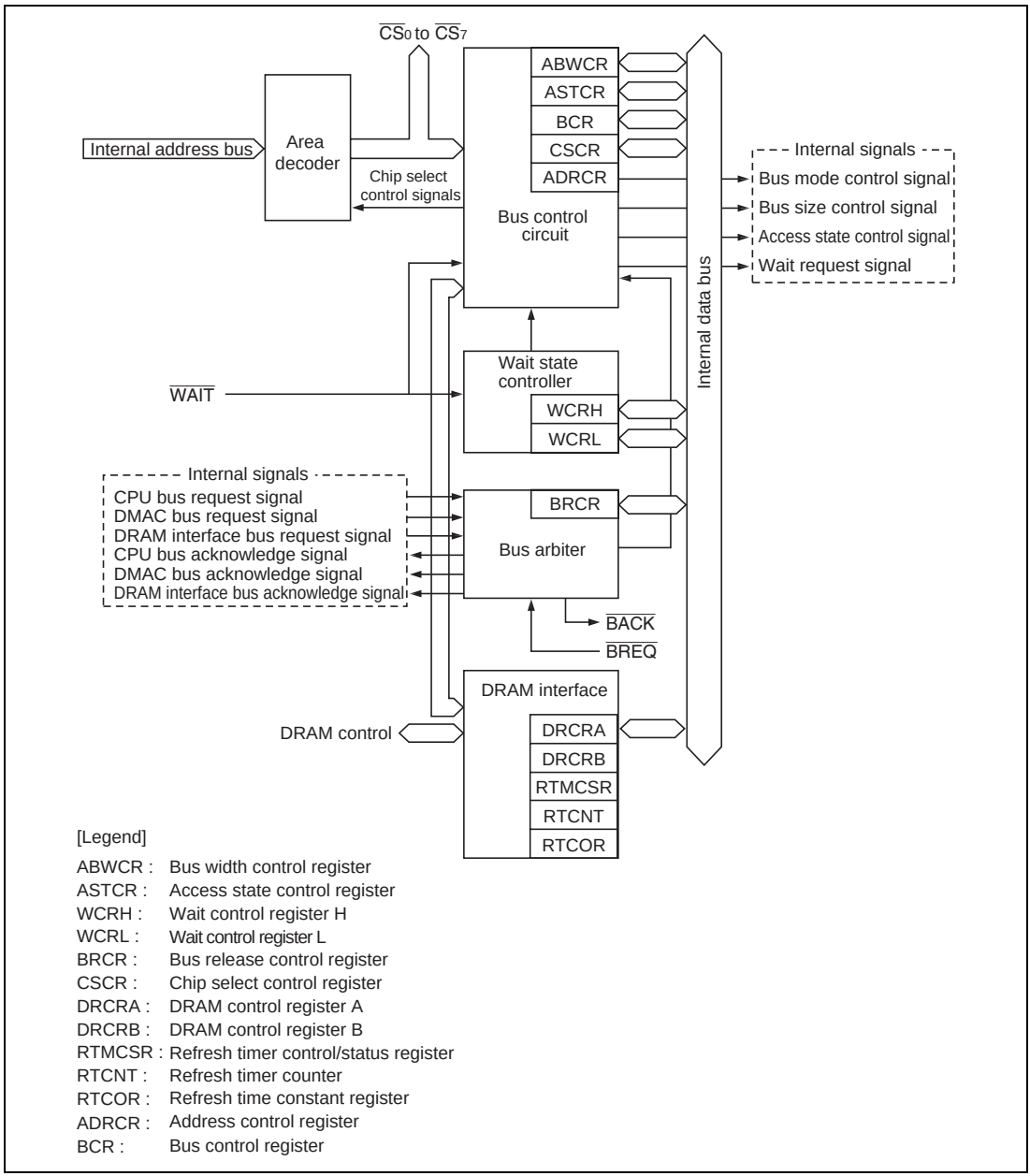


Figure 6.1 Block Diagram of Bus Controller

6.1.3 Pin Configuration

Table 6.1 summarizes the input/output pins of the bus controller.

Table 6.1 Bus Controller Pins

Name	Abbreviation	I/O	Function
Chip select 0 to 7	$\overline{CS}_0$ to $\overline{CS}_7$	Output	Strobe signals selecting areas 0 to 7
Address strobe	$\overline{AS}$	Output	Strobe signal indicating valid address output on the address bus
Read	$\overline{RD}$	Output	Strobe signal indicating reading from the external address space
High write	$\overline{HWR}$	Output	Strobe signal indicating writing to the external address space, with valid data on the upper data bus (D_{15} to D_8)
Low write	$\overline{LWR}$	Output	Strobe signal indicating writing to the external address space, with valid data on the lower data bus (D_7 to D_0)
Wait	$\overline{WAIT}$	Input	Wait request signal for access to external three-state access areas
Bus request	$\overline{BREQ}$	Input	Request signal for releasing the bus to an external device
Bus acknowledge	$\overline{BACK}$	Output	Acknowledge signal indicating release of the bus to an external device

6.1.4 Register Configuration

Table 6.2 summarizes the bus controller's registers.

Table 6.2 Bus Controller Registers

Address*[1]	Name	Abbreviation	R/W	Initial Value
H'EE020	Bus width control register	ABWCR	R/W	H'FF*[2]
H'EE021	Access state control register	ASTCR	R/W	H'FF
H'EE022	Wait control register H	WCRH	R/W	H'FF
H'EE023	Wait control register L	WCRL	R/W	H'FF
H'EE013	Bus release control register	BRCR	R/W	H'FE*[3]
H'EE01F	Chip select control register	CSCR	R/W	H'0F
H'EE01E	Address control register	ADRCR	R/W	H'FF
H'EE024	Bus control register	BCR	R/W	H'C6
H'EE026	DRAM control register A	DRCRA	R/W	H'10
H'EE027	DRAM control register B	DRCRB	R/W	H'08
H'EE028	Refresh timer control/status register	RTMCSR	R(W)*[4]	H'07
H'EE029	Refresh timer counter	RTCNT	R/W	H'00
H'EE02A	Refresh time constant register	RTCOR	R/W	H'FF

Notes: 1. Lower 20 bits of the address in advanced mode.
2. In modes 2 and 4, the initial value is H'00.
3. In modes 3 and 4, the initial value is H'EE.
4. For Bit 7, only 0 can be written to clear the flag.

6.2 Register Descriptions

6.2.1 Bus Width Control Register (ABWCR)

ABWCR is an 8-bit readable/writable register that selects 8-bit or 16-bit access for each area.

Bit		7	6	5	4	3	2	1	0
		ABW7	ABW6	ABW5	ABW4	ABW3	ABW2	ABW1	ABW0
Modes 1, 3, 5, and 7	Initial value	1	1	1	1	1	1	1	1
	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Modes 2 and 4	Initial value	0	0	0	0	0	0	0	0
	Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

When ABWCR contains H'FF (selecting 8-bit access for all areas), the chip operates in 8-bit bus mode: the upper data bus (D_{15} to D_8) is valid, and port 4 is an input/output port. When at least one bit is cleared to 0 in ABWCR, the chip operates in 16-bit bus mode with a 16-bit data bus (D_{15} to D_0). In modes 1, 3, 5, and 7, ABWCR is initialized to H'FF by a reset and in hardware standby mode. In modes 2 and 4, ABWCR is initialized to H'00 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bits 7 to 0—Area 7 to 0 Bus Width Control (ABW7 to ABW0): These bits select 8-bit access or 16-bit access for the corresponding areas.

Bits 7 to 0 ABW7 to ABW0	Description
0	Areas 7 to 0 are 16-bit access areas
1	Areas 7 to 0 are 8-bit access areas

ABWCR specifies the data bus width of external memory areas. The data bus width of on-chip memory and registers is fixed, and does not depend on ABWCR settings. These settings are therefore meaningless in the single-chip modes (mode 7).

6.2.2 Access State Control Register (ASTCR)

ASTCR is an 8-bit readable/writable register that selects whether each area is accessed in two states or three states.

Bit	7	6	5	4	3	2	1	0
	AST7	AST6	AST5	AST4	AST3	AST2	AST1	AST0
Initial value	1	1	1	1	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Bits selecting number of states for access to each area

ASTCR is initialized to H'FF by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bits 7 to 0—Area 7 to 0 Access State Control (AST7 to AST0): These bits select whether the corresponding area is accessed in two or three states.

Bits 7 to 0 AST7 to AST0	Description	
0	Areas 7 to 0 are accessed in two states	
1	Areas 7 to 0 are accessed in three states	(Initial value)

ASTCR specifies the number of states in which external areas are accessed. On-chip memory and registers are accessed in a fixed number of states that does not depend on ASTCR settings. These settings are therefore meaningless in the single-chip modes (mode 7).

When the corresponding area is designated as DRAM space by bits DRAS2 to DRAS0 in DRAM control register A (DRCRA), the number of access states does not depend on the AST bit setting. When an AST bit is cleared to 0, programmable wait insertion is not performed.

6.2.3 Wait Control Registers H and L (WCRH, WCRL)

WCRH and WCRL are 8-bit readable/writable registers that select the number of program wait states for each area.

On-chip memory and registers are accessed in a fixed number of states that does not depend on WCRH/WCRL settings.

WCRH and WCRL are initialized to H'FF by a reset and in hardware standby mode. They are not initialized in software standby mode.

WCRH

Bit	7	6	5	4	3	2	1	0
	W71	W70	W61	W60	W51	W50	W41	W40
Initial value	1	1	1	1	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Bits 7 and 6—Area 7 Wait Control 1 and 0 (W71, W70): These bits select the number of program wait states when area 7 in external space is accessed while the AST7 bit in ASTCR is set to 1.

Bit 7 W71	Bit 6 W70	Description
0	0	Program wait not inserted when external space area 7 is accessed
	1	1 program wait state inserted when external space area 7 is accessed
1	0	2 program wait states inserted when external space area 7 is accessed
	1	3 program wait states inserted when external space area 7 is accessed (Initial value)

Bits 5 and 4—Area 6 Wait Control 1 and 0 (W61, W60): These bits select the number of program wait states when area 6 in external space is accessed while the AST6 bit in ASTCR is set to 1.

Bit 5 W61	Bit 4 W60	Description
0	0	Program wait not inserted when external space area 6 is accessed
	1	1 program wait state inserted when external space area 6 is accessed
1	0	2 program wait states inserted when external space area 6 is accessed
	1	3 program wait states inserted when external space area 6 is accessed (Initial value)

Bits 3 and 2—Area 5 Wait Control 1 and 0 (W51, W50): These bits select the number of program wait states when area 5 in external space is accessed while the AST5 bit in ASTCR is set to 1.

Bit 3 W51	Bit 2 W50	Description
0	0	Program wait not inserted when external space area 5 is accessed
	1	1 program wait state inserted when external space area 5 is accessed
1	0	2 program wait states inserted when external space area 5 is accessed
	1	3 program wait states inserted when external space area 5 is accessed (Initial value)

Bits 1 and 0—Area 4 Wait Control 1 and 0 (W41, W40): These bits select the number of program wait states when area 4 in external space is accessed while the AST4 bit in ASTCR is set to 1.

Bit 1 W41	Bit 0 W40	Description
0	0	Program wait not inserted when external space area 4 is accessed
	1	1 program wait state inserted when external space area 4 is accessed
1	0	2 program wait states inserted when external space area 4 is accessed
	1	3 program wait states inserted when external space area 4 is accessed (Initial value)

WCRL

Bit	7	6	5	4	3	2	1	0
	W31	W30	W21	W20	W11	W10	W01	W00
Initial value	1	1	1	1	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Bits 7 and 6—Area 3 Wait Control 1 and 0 (W31, W30): These bits select the number of program wait states when area 3 in external space is accessed while the AST3 bit in ASTCR is set to 1.

Bit 7 W31	Bit 6 W30	Description
0	0	Program wait not inserted when external space area 3 is accessed
	1	1 program wait state inserted when external space area 3 is accessed
1	0	2 program wait states inserted when external space area 3 is accessed
	1	3 program wait states inserted when external space area 3 is accessed (Initial value)

Bits 5 and 4—Area 2 Wait Control 1 and 0 (W21, W20): These bits select the number of program wait states when area 2 in external space is accessed while the AST2 bit in ASTCR is set to 1.

Bit 5 W21	Bit 4 W20	Description
0	0	Program wait not inserted when external space area 2 is accessed
	1	1 program wait state inserted when external space area 2 is accessed
1	0	2 program wait states inserted when external space area 2 is accessed
	1	3 program wait states inserted when external space area 2 is accessed (Initial value)

Bits 3 and 2—Area 1 Wait Control 1 and 0 (W11, W10): These bits select the number of program wait states when area 1 in external space is accessed while the AST1 bit in ASTCR is set to 1.

Bit 3 W11	Bit 2 W10	Description
0	0	Program wait not inserted when external space area 1 is accessed
	1	1 program wait state inserted when external space area 1 is accessed
1	0	2 program wait states inserted when external space area 1 is accessed
	1	3 program wait states inserted when external space area 1 is accessed (Initial value)

Bits 1 and 0—Area 0 Wait Control 1 and 0 (W01, W00): These bits select the number of program wait states when area 0 in external space is accessed while the AST0 bit in ASTCR is set to 1.

Bit 1 W01	Bit 0 W00	Description
0	0	Program wait not inserted when external space area 0 is accessed
	1	1 program wait state inserted when external space area 0 is accessed
1	0	2 program wait states inserted when external space area 0 is accessed
	1	3 program wait states inserted when external space area 0 is accessed (Initial value)

6.2.4 Bus Release Control Register (BRCR)

BRCR is an 8-bit readable/writable register that enables address output on bus lines A_{23} to A_{20} and enables or disables release of the bus to an external device.

Bit		7	6	5	4	3	2	1	0
		A23E	A22E	A21E	A20E	—	—	—	BRLE
Modes 1, 2, and 7	Initial value	1	1	1	1	1	1	1	0
	Read/Write	—	—	—	—	—	—	—	R/W
Modes 3 and 4	Initial value	1	1	1	0	1	1	1	0
	Read/Write	R/W	R/W	R/W	—	—	—	—	R/W
Mode 5	Initial value	1	1	1	1	1	1	1	0
	Read/Write	R/W	R/W	R/W	R/W	—	—	—	R/W

Reserved bits

Address 23 to 20 enable
These bits enable PA_7 to PA_4 to be used for A_{23} to A_{20} address output

Bus release enable
Enables or disables release of the bus to an external device

BRCR is initialized to H'FE in modes 1, 2, 5, and 7, and to H'EE in modes 3 and 4, by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bit 7—Address 23 Enable (A23E): Enables PA_4 to be used as the A_{23} address output pin. Writing 0 in this bit enables A_{23} output from PA_4. In modes other than 3, 4, and 5, this bit cannot be modified and PA_4 has its ordinary port functions.

Bit 7 A23E	Description	
0	PA_4 is the A_{23} address output pin	
1	PA_4 is an input/output pin	(Initial value)

Bit 6—Address 22 Enable (A22E): Enables PA_5 to be used as the A_{22} address output pin. Writing 0 in this bit enables A_{22} output from PA_5. In modes other than 3, 4, and 5, this bit cannot be modified and PA_5 has its ordinary port functions.

Bit 6 A22E	Description	
0	PA_5 is the A_{22} address output pin	
1	PA_5 is an input/output pin	(Initial value)

Bit 5—Address 21 Enable (A21E): Enables PA_6 to be used as the A_{21} address output pin. Writing 0 in this bit enables A_{21} output from PA_6. In modes other than 3, 4, and 5, this bit cannot be modified and PA_6 has its ordinary port functions.

Bit 5 A21E	Description	
0	PA_6 is the A_{21} address output pin	
1	PA_6 is an input/output pin	(Initial value)

Bit 4—Address 20 Enable (A20E): Enables PA_7 to be used as the A_{20} address output pin. Writing 0 in this bit enables A_{20} output from PA_7. This bit can only be modified in mode 5.

Bit 4 A20E	Description
0	PA_7 is the A_{20} address output pin (Initial value when in mode 3 or 4)
1	PA_7 is an input/output pin (Initial value when in mode 1, 2, 5, or 7)

Bits 3 to 1—Reserved: These bits cannot be modified and are always read as 1.

Bit 0—Bus Release Enable (BRLE): Enables or disables release of the bus to an external device.

Bit 0 BRLE	Description	
0	The bus cannot be released to an external device $\overline{BREQ}$ and $\overline{BACK}$ can be used as input/output pins	(Initial value)
1	The bus can be released to an external device	

6.2.5 Bus Control Register (BCR)

Bit	7	6	5	4	3	2	1	0
	ICIS1	ICIS0	BROME	BRSTS1	BRSTS0	EMC	RDEA	WAITE
Initial value	1	1	0	0	0	1	1	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

BCR is an 8-bit readable/writable register that enables or disables idle cycle insertion, selects the address map, selects the area division unit, and enables or disables $\overline{WAIT}$ pin input.

BCR is initialized to H'C6 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bit 7—Idle Cycle Insertion 1 (ICIS1): Selects whether one idle cycle state is to be inserted between bus cycles in case of consecutive external read cycles for different areas.

Bit 7 ICIS1	Description
0	No idle cycle inserted in case of consecutive external read cycles for different areas
1	Idle cycle inserted in case of consecutive external read cycles for different areas (Initial value)

Bit 6—Idle Cycle Insertion 0 (ICIS0): Selects whether one idle cycle state is to be inserted between bus cycles in case of consecutive external read and write cycles.

Bit 6 ICIS0	Description
0	No idle cycle inserted in case of consecutive external read and write cycles
1	Idle cycle inserted in case of consecutive external read and write cycles (Initial value)

Bit 5—Burst ROM Enable (BROME): Selects whether area 0 is a burst ROM interface area.

Bit 5 BROME	Description
0	Area 0 is a basic bus interface area (Initial value)
1	Area 0 is a burst ROM interface area

Bit 4—Burst Cycle Select 1 (BRSTS1): Selects the number of burst cycle states for the burst ROM interface.

Bit 4 BRSTS1	Description
0	Burst access cycle comprises 2 states (Initial value)
1	Burst access cycle comprises 3 states

Bit 3—Burst Cycle Select 0 (BRSTS0): Selects the number of words that can be accessed in a burst ROM interface burst access.

Bit 3 BRSTS0	Description
0	Max. 4 words in burst access (burst access on match of address bits above A3) (Initial value)
1	Max. 8 words in burst access (burst access on match of address bits above A4)

Bit 2—Expansion Memory Map Control (EMC): Selects either of the two memory maps.

Bit 2 EMC	Description
0	Selects the memory map shown in figure 3.2: see section 3.6, Memory Map* in Each Operating Mode
1	Selects the memory map shown in figure 3.1: see section 3.6, Memory Map* in Each Operating Mode (Initial value)

Note: * When the memory map is switched using EMC, the following area combinations in the on-chip RAM area cannot be used.

		(EMC bit = 1)		(EMC bit = 0)
Mode 1 or 2	(1)	H'FDEE0 to H'FDF1F	↔	H'FBEE0 to H'FBF1F
	(2)	H'FFE80 to H'FFEDF	↔	H'FFF80 to H'FFFDF
	(3)	H'FFEE0 to H'FFF1F	↔	H'FDEE0 to H'FDF1F
Mode 3 or 4	(1)	H'FFDEE0 to H'FFDF1F	↔	H'FFBEE0 to H'FFBF1F
	(2)	H'FFFE80 to H'FFFEDF	↔	H'FFFF80 to H'FFFFDF
	(3)	H'FFFEE0 to H'FFFF1F	↔	H'FFDEE0 to H'FFDF1F
Mode 5	(1)	H'FFDEE0 to H'FFDF1F	↔	H'FFBEE0 to H'FFBF1F
	(2)	H'FFFE80 to H'FFFEDF	↔	H'FFFF80 to H'FFFFDF
	(3)	H'FFFEE0 to H'FFFF1F	↔	H'FFDEE0 to H'FFDF1F
Mode 7	(1)	H'FDEE0 to H'FDF1F	↔	H'FBEE0 to H'FBF1F
	(2)	H'FFE80 to H'FFEDF	↔	H'FFF80 to H'FFFDF
	(3)	H'FFEE0 to H'FFF1F	↔	H'FDEE0 to H'FDF1F

When EMC is cleared to 0, addresses of some internal I/O registers are moved. For details, refer to appendix B.2, Addresses (EMC = 0).

When the RDEA bit is 0, EMC must not be cleared to 0.

Bit 1—Area Division Unit Select (RDEA): Selects the memory map area division units. This bit is valid in modes 3, 4, and 5, and is invalid in modes 1, 2, and 7.

When the EMC bit is 0, RDEA must not be cleared to 0.

Bit 1 RDEA	Description		
0	Area divisions are as follows:	Area 0: 2 Mbytes	Area 4: 1.93 Mbytes
		Area 1: 2 Mbytes	Area 5: 4 kbytes
		Area 2: 8 Mbytes	Area 6: 23.75 kbytes
		Area 3: 2 Mbytes	Area 7: 22 bytes
1	Areas 0 to 7 are the same size (2 Mbytes)		(Initial value)

Bit 0—WAIT Pin Enable (WAITE): Enables or disables wait insertion by means of the $\overline{\text{WAIT}}$ pin.

Bit 0 WAITE	Description
0	$\overline{\text{WAIT}}$ pin wait input is disabled, and the $\overline{\text{WAIT}}$ pin can be used as an input/output port (Initial value)
1	$\overline{\text{WAIT}}$ pin wait input is enabled

6.2.6 Chip Select Control Register (CSCR)

CSCR is an 8-bit readable/writable register that enables or disables output of chip select signals ($\overline{CS}_7$ to $\overline{CS}_4$).

If output of a chip select signal is enabled by a setting in this register, the corresponding pin functions as a chip select signal ($\overline{CS}_7$ to $\overline{CS}_4$) output regardless of any other settings. CSCR cannot be modified in single-chip mode.

Bit	7	6	5	4	3	2	1	0
	CS7E	CS6E	CS5E	CS4E	—	—	—	—
Initial value	0	0	0	0	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	—	—	—	—

Chip select 7 to 4 enable
These bits enable or disable chip select signal output

Reserved bits

CSCR is initialized to H'0F by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bits 7 to 4—Chip Select 7 to 4 Enable (CS7E to CS4E): These bits enable or disable output of the corresponding chip select signal.

Bit n CSnE	Description	
0	Output of chip select signal $\overline{CSn}$ is disabled	(Initial value)
1	Output of chip select signal $\overline{CSn}$ is enabled	

Note: n = 7 to 4

Bits 3 to 0—Reserved: These bits cannot be modified and are always read as 1.

6.2.7 DRAM Control Register A (DRCRA)

Bit	7	6	5	4	3	2	1	0
	DRAS2	DRAS1	DRAS0	—	BE	RDM	SRFMD	RFSHE
Initial value	0	0	0	1	0	0	0	0
Read/Write	R/W	R/W	R/W	—	R/W	R/W	R/W	R/W

DRCRA is an 8-bit readable/writable register that selects the areas that have a DRAM interface function, and the access mode, and enables or disables self-refreshing and refresh pin output.

DRCRA is initialized to H'10 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bits 7 to 5—DRAM Area Select (DRAS2 to DRAS0): These bits select which of areas 2 to 5 are to function as DRAM interface areas (DRAM space) in expanded mode, and at the same time select the $\overline{RAS}$ output pin corresponding to each DRAM space.

			Description			
Bit 7 DRAS2	**Bit 6 DRAS1**	**Bit 5 DRAS0**	**Area 5**	**Area 4**	**Area 3**	**Area 2**
0	0	0	Normal	Normal	Normal	Normal
		1	Normal	Normal	Normal	DRAM space ($\overline{CS_2}$)
	1	0	Normal	Normal	DRAM space ($\overline{CS_3}$)	DRAM space ($\overline{CS_2}$)
		1	Normal	Normal	DRAM space ($\overline{CS_2}$)*	DRAM space ($\overline{CS_2}$)*
1	0	0	Normal	DRAM space ($\overline{CS_4}$)	DRAM space ($\overline{CS_3}$)	DRAM space ($\overline{CS_2}$)
		1	DRAM space ($\overline{CS_5}$)	DRAM space ($\overline{CS_4}$)	DRAM space ($\overline{CS_3}$)	DRAM space ($\overline{CS_2}$)
	1	0	DRAM space ($\overline{CS_4}$)*	DRAM space ($\overline{CS_4}$)*	DRAM space ($\overline{CS_2}$)*	DRAM space ($\overline{CS_2}$)*
		1	DRAM space ($\overline{CS_2}$)*	DRAM space ($\overline{CS_2}$)*	DRAM space ($\overline{CS_2}$)*	DRAM space ($\overline{CS_2}$)*

Note: * A single $\overline{CSn}$ pin serves as a common $\overline{RAS}$ output pin for a number of areas. Unused $\overline{CSn}$ pins can be used as input/output ports.

When any of bits DRAS2 to DRAS0 is set to 1 in expanded mode, it is not possible to write to DRCRB, RTMCSR, RTCNT, or RTCOR. However, 0 can be written to the CMF flag in RTMCSR to clear the flag.

When an arbitrary value has been set in DRAS2 to DRAS0, a write of a different value other than 000 must not be performed.

Bit 4—Reserved: This bit cannot be modified and is always read as 1.

Bit 3—Burst Access Enable (BE): Enables or disables burst access to DRAM space. DRAM space burst access is performed in fast page mode.

Bit 3 BE	Description	
0	Burst disabled (always full access)	(Initial value)
1	DRAM space access performed in fast page mode	

Bit 2—RAS Down Mode (RDM): Selects whether to wait for the next DRAM access with the $\overline{\text{RAS}}$ signal held low (RAS down mode), or to drive the RAS signal high again (RAS up mode), when burst access is enabled for DRAM space (BE = 1), and access to DRAM is interrupted.

Caution is required when the $\overline{\text{HWR}}$ and $\overline{\text{LWR}}$ are used as the $\overline{\text{UCAS}}$ and $\overline{\text{LCAS}}$ output pins. For details, see RAS Down Mode and RAS Up Mode in section 6.5.10, Burst Operation.

Bit 2 RDM	Description	
0	DRAM interface: RAS up mode selected	(Initial value)
1	DRAM interface: RAS down mode selected	

Bit 1—Self-Refresh Mode (SRFMD): Specifies DRAM self-refreshing in software standby mode.

When any of areas 2 to 5 is designated as DRAM space, DRAM self-refreshing is possible when a transition is made to software standby mode after the SRFMD bit has been set to 1.

The normal access state is restored when software standby mode is exited, regardless of the SRFMD setting.

Bit 1 SRFMD	Description	
0	DRAM self-refreshing disabled in software standby mode	(Initial value)
1	DRAM self-refreshing enabled in software standby mode	

Bit 0—Refresh Pin Enable (RFSHE): Enables or disables $\overline{\text{RFSH}}$ pin refresh signal output. If areas 2 to 5 are not designated as DRAM space, this bit should not be set to 1.

Bit 0 RFSHE	Description	
0	$\overline{\text{RFSH}}$ pin refresh signal output disabled ($\overline{\text{RFSH}}$ pin can be used as input/output port)	(Initial value)
1	$\overline{\text{RFSH}}$ pin refresh signal output enabled	

6.2.8 DRAM Control Register B (DRCRB)

Bit	7	6	5	4	3	2	1	0
	MXC1	MXC0	CSEL	RCYCE	—	TPC	RCW	RLW
Initial value	0	0	0	0	1	0	0	0
Read/Write	R/W	R/W	R/W	R/W	—	R/W	R/W	R/W

DRCRB is an 8-bit readable/writable register that selects the number of address multiplex column address bits for the DRAM interface, the column address strobe output pin, enabling or disabling of refresh cycle insertion, the number of precharge cycles, enabling or disabling of wait state insertion between $\overline{\text{RAS}}$ and $\overline{\text{CAS}}$, and enabling or disabling of wait state insertion in refresh cycles.

DRCRB is initialized to H'08 by a reset and in hardware standby mode. It is not initialized in software standby mode.

The settings in this register are invalid when bits DRAS2 to DRAS0 in DRCRA are all 0.

Bits 7 and 6—Multiplex Control 1 and 0 (MXC1, MXC0): These bits select the row address/column address multiplexing method used on the DRAM interface. In burst operation, the row address used for comparison is determined by the setting of these bits and the bus width of the relevant area set in ABWCR.

Bit 7 MXC1	Bit 6 MXC0	Description		
0	0	Column address: 8 bits		
		Compared address:		
		Modes 1, 2	8-bit access space	A_{19} to A_8
			16-bit access space	A_{19} to A_9
		Modes 3, 4, 5	8-bit access space	A_{23} to A_8
			16-bit access space	A_{23} to A_9
	1	Column address: 9 bits		
		Compared address:		
		Modes 1, 2	8-bit access space	A_{19} to A_9
			16-bit access space	A_{19} to A_{10}
		Modes 3, 4, 5	8-bit access space	A_{23} to A_9
			16-bit access space	A_{23} to A_{10}
1	0	Column address: 10 bits		
		Compared address:		
		Modes 1, 2	8-bit access space	A_{19} to A_{10}
			16-bit access space	A_{19} to A_{11}
		Modes 3, 4, 5	8-bit access space	A_{23} to A_{10}
			16-bit access space	A_{23} to A_{11}
	1	Illegal setting		

Bit 5—$\overline{\text{CAS}}$ Output Pin Select (CSEL): Selects the $\overline{\text{UCAS}}$ and $\overline{\text{LCAS}}$ output pins when areas 2 to 5 are designated as DRAM space.

Bit 5 CSEL	Description	
0	PB4 and PB5 selected as $\overline{\text{UCAS}}$ and $\overline{\text{LCAS}}$ output pins	(Initial value)
1	$\overline{\text{HWR}}$ and $\overline{\text{LWR}}$ selected as $\overline{\text{UCAS}}$ and $\overline{\text{LCAS}}$ output pins	

Bit 4—Refresh Cycle Enable (RCYCE): Enables or disables CAS-before-RAS refresh cycle insertion. When none of areas 2 to 5 has been designated as DRAM space, refresh cycles are not inserted regardless of the setting of this bit.

Bit 4 RCYCE	Description	
0	Refresh cycles disabled	(Initial value)
1	DRAM refresh cycles enabled	

Bit 3—Reserved: This bit cannot be modified and is always read as 1.

Bit 2—TP Cycle Control (TPC): Selects whether a 1-state or two-state precharge cycle (T_p) is to be used for DRAM read/write cycles and CAS-before-RAS refresh cycles.

The setting of this bit does not affect the self-refresh function.

Bit 2 TPC	Description	
0	1-state precharge cycle inserted	(Initial value)
1	2-state precharge cycle inserted	

Bit 1—$\overline{\text{RAS}}$-$\overline{\text{CAS}}$ Wait (RCW): Controls wait state (Trw) insertion between T_r and T_{c1} in DRAM read/write cycles. The setting of this bit does not affect refresh cycles.

Bit 1 RCW	Description	
0	Wait state (Trw) insertion disabled	(Initial value)
1	One wait state (Trw) inserted	

Bit 0—Refresh Cycle Wait Control (RLW): Controls wait state (T_{RW}) insertion for CAS-before-RAS refresh cycles. The setting of this bit does not affect DRAM read/write cycles.

Bit 0 RLW	Description	
0	Wait state (T_{RW}) insertion disabled	(Initial value)
1	One wait state (T_{RW}) inserted	

6.2.9 Refresh Timer Control/Status Register (RTMCSR)

Bit	7	6	5	4	3	2	1	0
	CMF	CMIE	CKS2	CKS1	CKS0	—	—	—
Initial value	0	0	0	0	0	1	1	1
Read/Write	R(W)*	R/W	R/W	R/W	R/W	—	—	—

RTMCSR is an 8-bit readable/writable register that selects the refresh timer counter clock. When the refresh timer is used as an interval timer, RTMCSR also enables or disables interrupt requests. Bits 7 and 6 of RTMCSR are initialized to 0 by a reset and in the standby modes. Bits 5 to 3 are initialized to 0 by a reset and in hardware standby mode; they are not initialized in software standby mode.

Note: * Only 0 can be written to clear the flag.

Bit 7—Compare Match Flag (CMF): Status flag that indicates a match between the values of RTCNT and RTCOR.

Bit 7 CMF	Description	
0	[Clearing conditions] When the chip is reset and in standby mode Read CMF when CMF = 1, then write 0 in CMF	(Initial value)
1	[Setting condition] When RTCNT = RTCOR	

Bit 6—Compare Match Interrupt Enable (CMIE): Enables or disables the CMI interrupt requested when the CMF flag is set to 1 in RTMCSR. The CMIE bit is always cleared to 0 when any of areas 2 to 5 is designated as DRAM space.

Bit 6 CMIE	Description	
0	The CMI interrupt requested by CMF is disabled	(Initial value)
1	The CMI interrupt requested by CMF is enabled	

Bits 5 to 3—Refresh Counter Clock Select (CKS2 to CKS0): These bits select the clock to be input to RTCNT from among 7 clocks obtained by dividing the system clock (ϕ). When the input clock is selected with bits CKS2 to CKS0, RTCNT begins counting up.

Bit 5 CKS2	Bit 4 CKS1	Bit 3 CKS0	Description	
0	0	0	Count operation halted	(Initial value)
		1	ϕ/2 used as counter clock	
	1	0	ϕ/8 used as counter clock	
		1	ϕ/32 used as counter clock	
1	0	0	ϕ/128 used as counter clock	
		1	ϕ/512 used as counter clock	
	1	0	ϕ/2048 used as counter clock	
		1	ϕ/4096 used as counter clock	

Bits 2 to 0—Reserved: These bits cannot be modified and are always read as 1.

6.2.10 Refresh Timer Counter (RTCNT)

Bit	7	6	5	4	3	2	1	0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

RTCNT is an 8-bit readable/writable up-counter.

RTCNT is incremented by an internal clock selected by bits CKS2 to CKS0 in RTMCSR. When RTCNT matches RTCOR (compare match), the CMF flag in RTMCSR is set to 1 and RTCNT is cleared to H'00. If the RCYCE bit in DRCRB is set to 1 at this time, a refresh cycle is started. Also, if the CMIE bit in RTMCSR is set to 1, a compare match interrupt (CMI) is generated.

RTCNT is initialized to H'00 by a reset and in standby mode.

6.2.11 Refresh Time Constant Register (RTCOR)

Bit	7	6	5	4	3	2	1	0
Initial value	1	1	1	1	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

RTCOR is an 8-bit readable/writable register that determines the interval at which RTCNT is cleared.

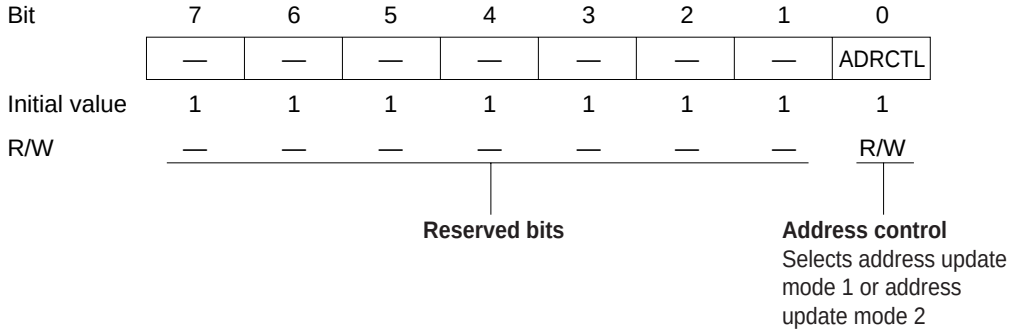
RTCOR and RTCNT are constantly compared. When their values match, the CMF flag is set to 1 in RTMCSR, and RTCNT is simultaneously cleared to H'00.

RTCOR is initialized to H'FF by a reset and in hardware standby mode. It is not initialized in software standby mode.

Note: Only byte access can be used on this register.

6.2.12 Address Control Register (ADRCR)

ADRCR is an 8-bit readable/writable register that selects either address update mode 1 or address update mode 2 as the address output method.



ADRCR is initialized to H'FF by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bits 7 to 1—Reserved: Read-only bits, always read as 1.

Bit 0—Address Control (ADRCTL): Selects the address output method.

Bit 0 ADRCTL	Description	
0	Address update mode 2 is selected	
1	Address update mode 1 is selected	(Initial value)

6.3 Operation

6.3.1 Area Division

The external address space is divided into areas 0 to 7. Each area has a size of 128 kbytes in the 1-Mbyte modes, or 2-Mbytes in the 16-Mbyte modes. Figure 6.2 shows a general view of the memory map.

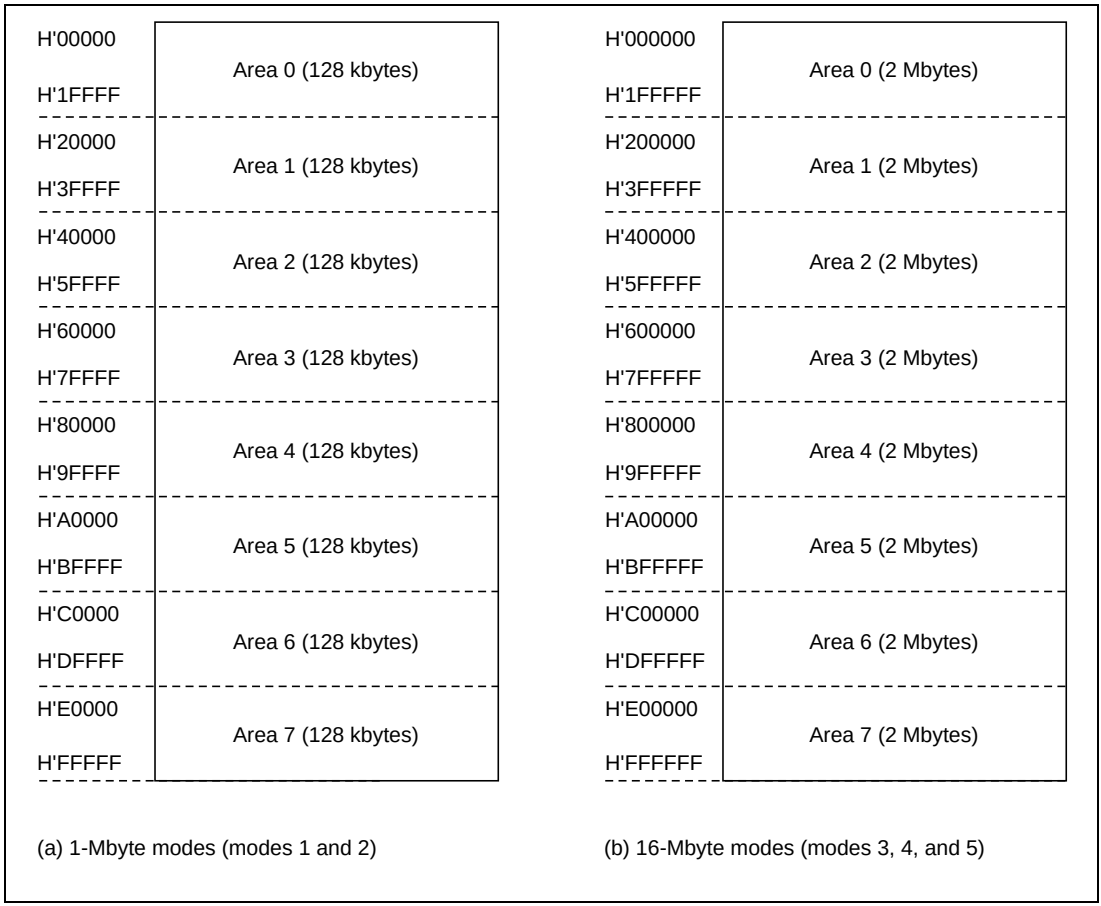
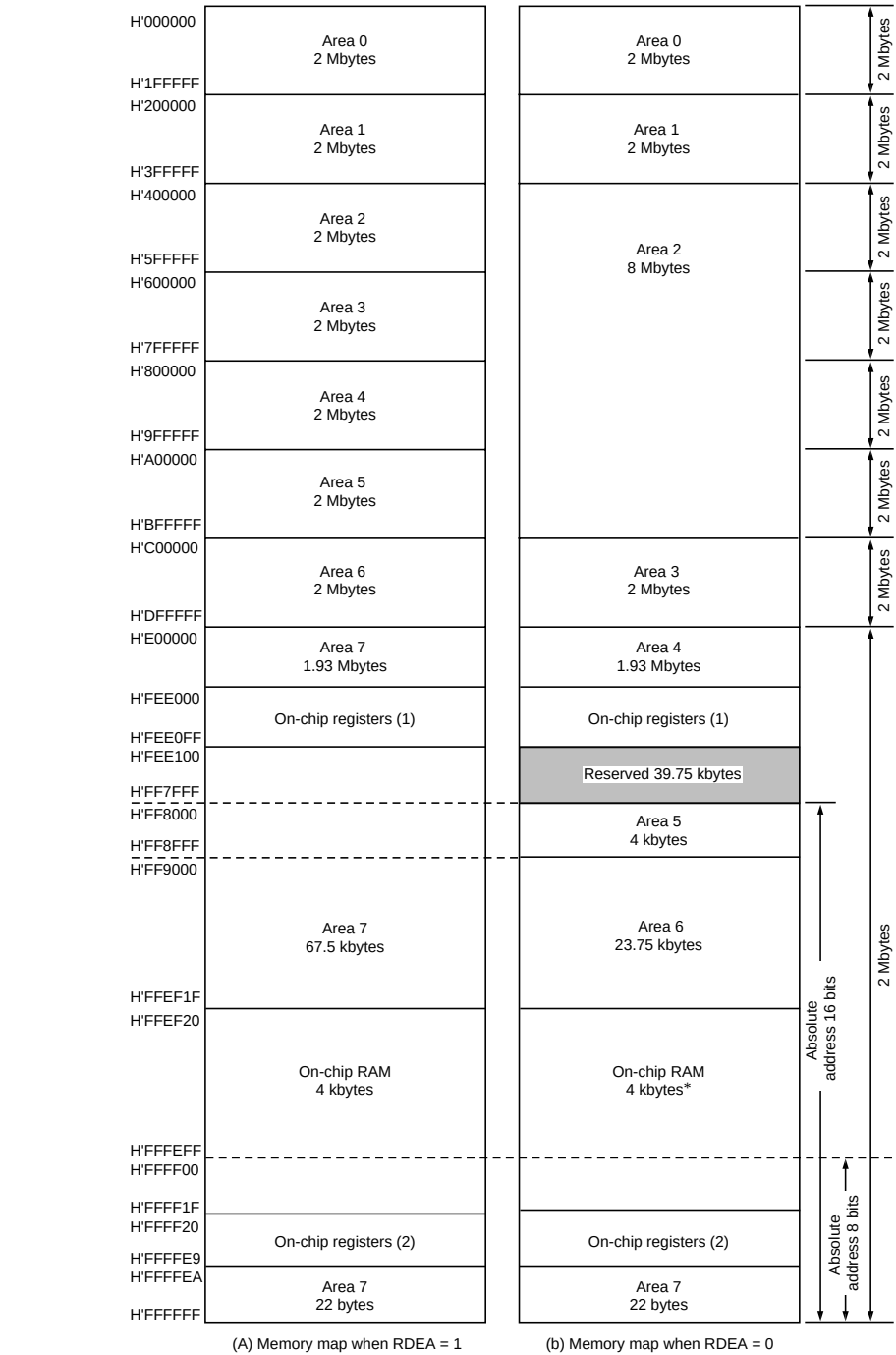


Figure 6.2 Access Area Map for Each Operating Mode

Chip select signals ($\overline{CS}_0$ to $\overline{CS}_7$) can be output for areas 0 to 7. The bus specifications for each area are selected in ABWCR, ASTCR, WCRH, and WCRL.

In 16-Mbyte mode, the area division units can be selected with the RDEA bit in BCR.



Note: * Area 6 when the RAME bit is cleared.

Figure 6.3 Memory Map in 16-Mbyte Mode

6.3.2 Bus Specifications

The external space bus specifications consist of three elements: (1) bus width, (2) number of access states, and (3) number of program wait states.

The bus width and number of access states for on-chip memory and registers are fixed, and are not affected by the bus controller.

Bus Width: A bus width of 8 or 16 bits can be selected with ABWCR. An area for which an 8-bit bus is selected functions as an 8-bit access space, and an area for which a 16-bit bus is selected functions as a16-bit access space.

If all areas are designated for 8-bit access, 8-bit bus mode is set; if any area is designated for 16-bit access, 16-bit bus mode is set.

Number of Access States: Two or three access states can be selected with ASTCR. An area for which two-state access is selected functions as a two-state access space, and an area for which three-state access is selected functions as a three-state access space.

DRAM space is accessed in four states regardless of the ASTCR settings.

When two-state access space is designated, wait insertion is disabled.

Number of Program Wait States: When three-state access space is designated in ASTCR, the number of program wait states to be inserted automatically is selected with WCRH and WCRL. From 0 to 3 program wait states can be selected.

When ASTCR is cleared to 0 for DRAM space, a program wait (T_{c1}-T_{c2} wait) is not inserted. Also, no program wait is inserted in burst ROM space burst cycles.

Table 6.3 shows the bus specifications for each basic bus interface area.

Table 6.3 Bus Specifications for Each Area (Basic Bus Interface)

ABWCR	ASTCR	WCRH/WCRL		Bus Specifications (Basic Bus Interface)		
ABWn	ASTn	Wn1	Wn0	Bus Width	Access States	Program Wait States
0	0	—	—	16	2	0
	1	0	0		3	0
			1			1
		1	0			2
			1			3
1	0	—	—	8	2	0
	1	0	0		3	0
			1			1
		1	0			2
			1			3

Note: n = 7 to 0

6.3.3 Memory Interfaces

The H8/3069R memory interfaces comprise a basic bus interface that allows direct connection of ROM, SRAM, and so on; a DRAM interface that allows direct connection of DRAM; and a burst ROM interface that allows direct connection of burst ROM. The interface can be selected independently for each area.

An area for which the basic bus interface is designated functions as normal space, an area for which the DRAM interface is designated functions as DRAM space, and area 0 for which the burst ROM interface is designated functions as burst ROM space.

6.3.4 Chip Select Signals

For each of areas 0 to 7, the H8/3069R can output a chip select signal ($\overline{CS}_0$ to $\overline{CS}_7$) that goes low when the corresponding area is selected in expanded mode. Figure 6.4 shows the output timing of a $\overline{CS}$n signal.

Output of $\overline{CS}_0$ to $\overline{CS}_3$: Output of $\overline{CS}_0$ to $\overline{CS}_3$ is enabled or disabled in the data direction register (DDR) of the corresponding port.

In the expanded modes with on-chip ROM disabled, a reset leaves pin $\overline{CS}_0$ in the output state and pins $\overline{CS}_1$ to $\overline{CS}_3$ in the input state. To output chip select signals $\overline{CS}_1$ to $\overline{CS}_3$, the corresponding DDR bits must be set to 1. In the expanded modes with on-chip ROM enabled, a reset leaves pins $\overline{CS}_0$ to $\overline{CS}_3$ in the input state. To output chip select signals $\overline{CS}_0$ to $\overline{CS}_3$, the corresponding DDR bits must be set to 1. For details, see section 8, I/O Ports.

Output of $\overline{CS}_4$ to $\overline{CS}_7$: Output of $\overline{CS}_4$ to $\overline{CS}_7$ is enabled or disabled in the chip select control register (CSCR). A reset leaves pins $\overline{CS}_4$ to $\overline{CS}_7$ in the input state. To output chip select signals $\overline{CS}_4$ to $\overline{CS}_7$, the corresponding CSCR bits must be set to 1. For details, see section 8, I/O Ports.

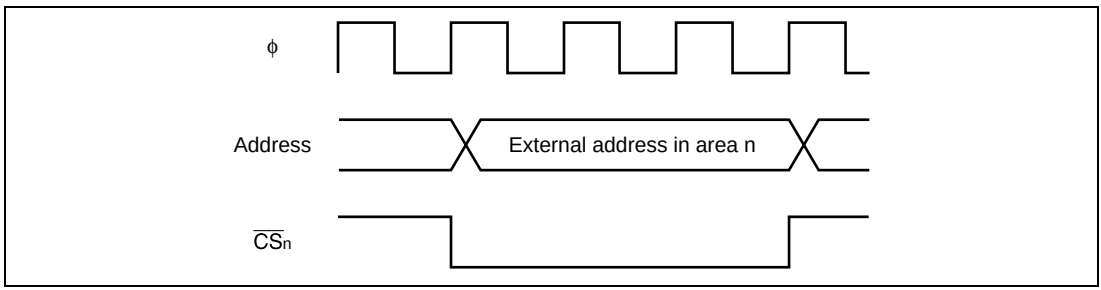


Figure 6.4 $\overline{CS}$n Signal Output Timing (n = 0 to 7)

When the on-chip ROM, on-chip RAM, and on-chip registers are accessed, $\overline{CS}_0$ to $\overline{CS}_7$ remain high. The $\overline{CS}_n$ signals are decoded from the address signals. They can be used as chip select signals for SRAM and other devices.

6.3.5 Address Output Method

The H8/3069R provides a choice of two address update methods: either the same method as in the previous H8/300H Series (address update mode 1), or a method in which address update is restricted to external space accesses or self-refresh cycles (address update mode 2).

Figure 6.5 shows examples of address output in these two update modes.

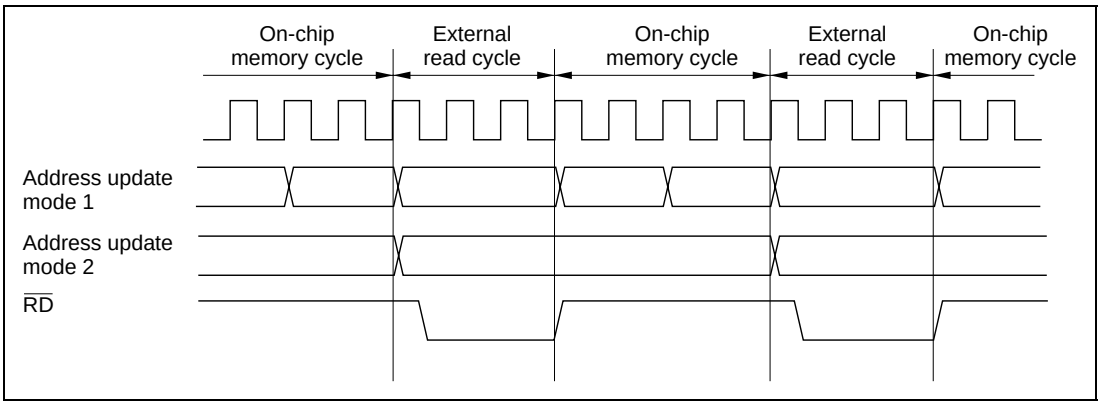


Figure 6.5 Sample Address Output in Each Address Update Mode (Basic Bus Interface, 3-State Space)

Address Update Mode 1: Address update mode 1 is compatible with the previous H8/300H Series. Addresses are always updated between bus cycles.

Address Update Mode 2: In address update mode 2, address updating is performed only in external space accesses or self-refresh cycles. In this mode, the address can be retained between an external space read cycle and an instruction fetch cycle (on-chip memory) by placing the program in on-chip memory. Address update mode 2 is therefore useful when connecting a device that requires address hold time with respect to the rise of the $\overline{RD}$ strobe.

Switching between address update modes 1 and 2 is performed by means of the ADRCTL bit in ADRCR. The initial value of ADRCR is the address update mode 1 setting, providing compatibility with the previous H8/300H Series.

Cautions: When using address update modes, the following points should be noted.

- When address update mode 2 is selected, the address in an internal space (on-chip memory or internal I/O) access cycle is not output externally.
- In order to secure address holding with respect to the rise of $\overline{RD}$, when address update mode 2 is used an external space read access must be completed within a single access cycle. For example, in a word access to 8-bit access space, the bus cycle is split into two as shown in figure 6.6, and so there is not a single access cycle. In this case, address holding is not guaranteed at the rise of $\overline{RD}$ between the first (even address) and second (odd address) access cycles (area inside the ellipse in the figure).

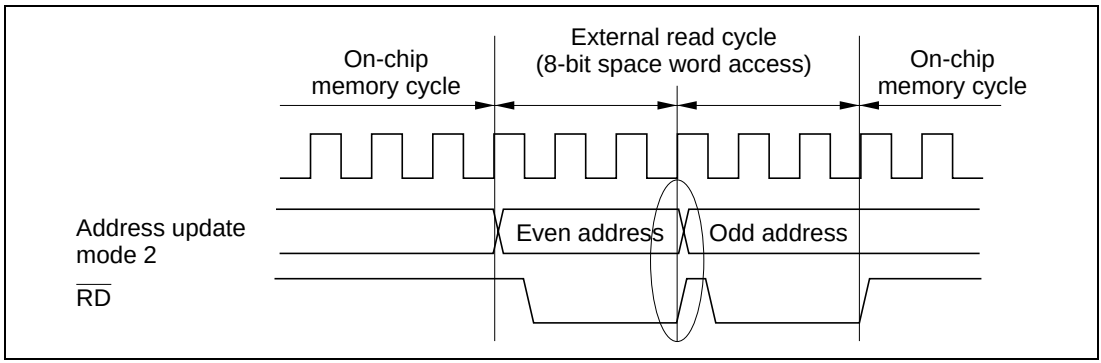


Figure 6.6 Example of Consecutive External Space Accesses in Address Update Mode 2

- When address update mode 2 is selected, in a DRAM space CAS-before-RAS (CBR) refresh cycle the previous address is retained (the area 2 start address is not output).

6.4 Basic Bus Interface

6.4.1 Overview

The basic bus interface enables direct connection of ROM, SRAM, and so on.

The bus specifications can be selected with ABWCR, ASTCR, WCRH, and WCRL (see table 6.3).

6.4.2 Data Size and Data Alignment

Data sizes for the CPU and other internal bus masters are byte, word, and longword. The bus controller has a data alignment function, and when accessing external space, controls whether the upper data bus (D_{15} to D_8) or lower data bus (D_7 to D_0) is used according to the bus specifications for the area being accessed (8-bit access area or 16-bit access area) and the data size.

8-Bit Access Areas: Figure 6.7 illustrates data alignment control for 8-bit access space. With 8-bit access space, the upper data bus (D_{15} to D_8) is always used for accesses. The amount of data that can be accessed at one time is one byte: a word access is performed as two byte accesses, and a longword access, as four byte accesses.

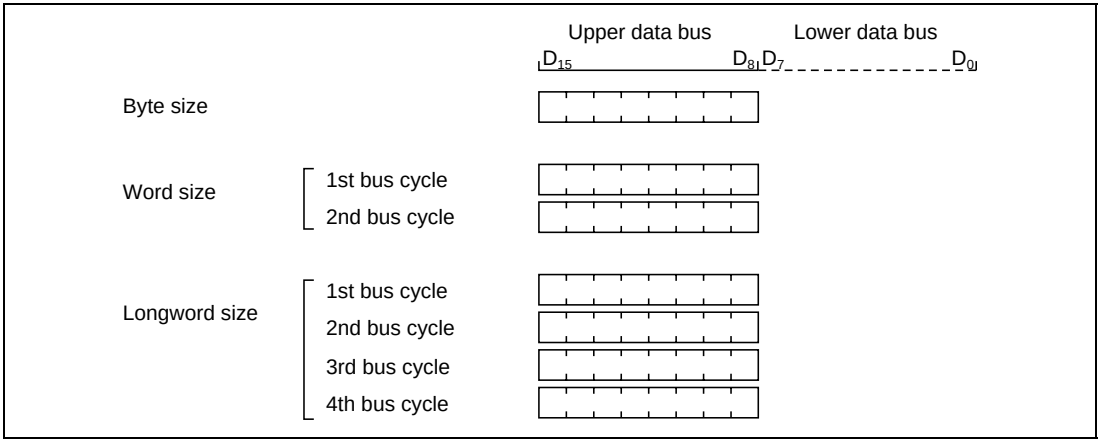


Figure 6.7 Access Sizes and Data Alignment Control (8-Bit Access Area)

16-Bit Access Areas: Figure 6.8 illustrates data alignment control for 16-bit access areas. With 16-bit access areas, the upper data bus (D_{15} to D_8) and lower data bus (D_7 to D_0) are used for accesses. The amount of data that can be accessed at one time is one byte or one word, and a longword access is executed as two word accesses.

In byte access, whether the upper or lower data bus is used is determined by whether the address is even or odd. The upper data bus is used for an even address, and the lower data bus for an odd address.

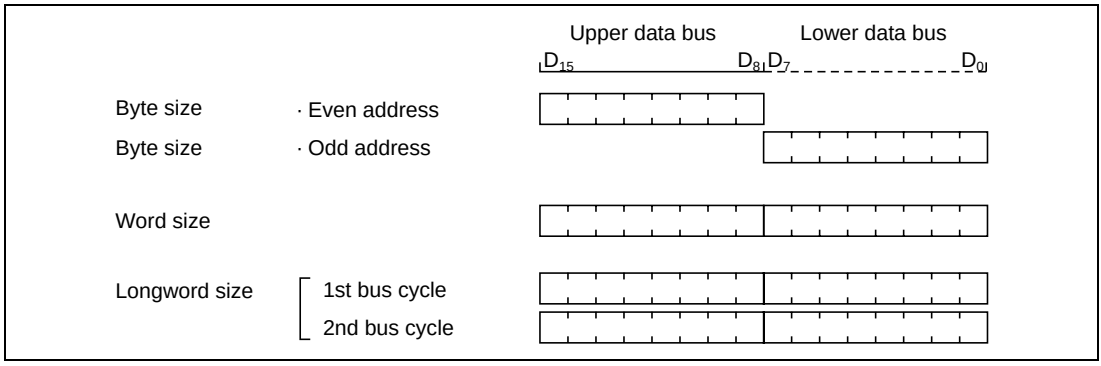


Figure 6.8 Access Sizes and Data Alignment Control (16-Bit Access Area)

6.4.3 Valid Strobes

Table 6.4 shows the data buses used, and the valid strobes, for the access spaces.

In a read, the $\overline{RD}$ signal is valid for both the upper and the lower half of the data bus.

In a write, the $\overline{HWR}$ signal is valid for the upper half of the data bus, and the $\overline{LWR}$ signal for the lower half.

Table 6.4 Data Buses Used and Valid Strobes

Area	Access Size	Read/Write	Address	Valid Strobe	Upper Data Bus (D_{15} to D_8)	Lower Data Bus (D_7 to D_0)
8-bit access area	Byte	Read	—	$\overline{RD}$	Valid	Invalid
		Write	—	$\overline{HWR}$		Undetermined data
16-bit access area	Byte	Read	Even	$\overline{RD}$	Valid	Invalid
			Odd		Invalid	Valid
		Write	Even	$\overline{HWR}$	Valid	Undetermined data
			Odd	$\overline{LWR}$	Undetermined data	Valid
	Word	Read	—	$\overline{RD}$	Valid	Valid
		Write	—	$\overline{HWR}$, $\overline{LWR}$	Valid	Valid

Notes: 1. Undetermined data means that unpredictable data is output.
2. Invalid means that the bus is in the input state and the input is ignored.

6.4.4 Memory Areas

The initial state of each area is basic bus interface, three-state access space. The initial bus width is selected according to the operating mode. The bus specifications described here cover basic items only, and the following sections should be referred to for further details: Sections 6.4, Basic Bus Interface, 6.5, DRAM Interface, and 6.8, Burst ROM Interface.

Area 0: Area 0 includes on-chip ROM, and in ROM-disabled expansion mode, all of area 0 is external space. In ROM-enabled expansion mode, the space excluding on-chip ROM is external space.
When area 0 external space is accessed, the $\overline{CS}_0$ signal can be output.
Either basic bus interface or burst ROM interface can be selected for area 0.
The size of area 0 is 128 kbytes in modes 1 and 2, and 2 Mbytes in modes 3, 4, and 5.

Areas 1 and 6: In external expansion mode, areas 1 and 6 are entirely external space.
When area 1 and 6 external space is accessed, the $\overline{CS}_1$ and $\overline{CS}_6$ pin signals respectively can be output.
Only the basic bus interface can be used for areas 1 and 6.
The size of areas 1 and 6 is 128 kbytes in modes 1 and 2, and 2 Mbytes in modes 3, 4, and 5.

Areas 2 to 5: In external expansion mode, areas 2 to 5 are entirely external space.
When area 2 to 5 external space is accessed, signals $\overline{CS}_2$ to $\overline{CS}_5$ can be output.
Basic bus interface or DRAM interface can be selected for areas 2 to 5. With the DRAM interface, signals $\overline{CS}_2$ to $\overline{CS}_5$ are used as $\overline{RAS}$ signals.
The size of areas 2 to 5 is 128 kbytes in modes 1 and 2, and 2 Mbytes in modes 3, 4, and 5.

Area 7: Area 7 includes the on-chip RAM and registers. In external expansion mode, the space excluding the on-chip RAM and registers is external space. The on-chip RAM is enabled when the RAME bit in the system control register (SYSCR) is set to 1; when the RAME bit is cleared to 0, the on-chip RAM is disabled and the corresponding space becomes external space .
When area 7 external space is accessed, the $\overline{CS}_7$ signal can be output.
Only the basic bus interface can be used for the area 7 memory interface.
The size of area 7 is 128 kbytes in modes 1 and 2, and 2 Mbytes in modes 3, 4, and 5.

6.4.5 Basic Bus Control Signal Timing

8-Bit, Three-State-Access Areas

Figure 6.9 shows the timing of bus control signals for an 8-bit, three-state-access area. The upper data bus (D_{15} to D_8) is used in accesses to these areas. The $\overline{LWR}$ pin is always high. Wait states can be inserted.

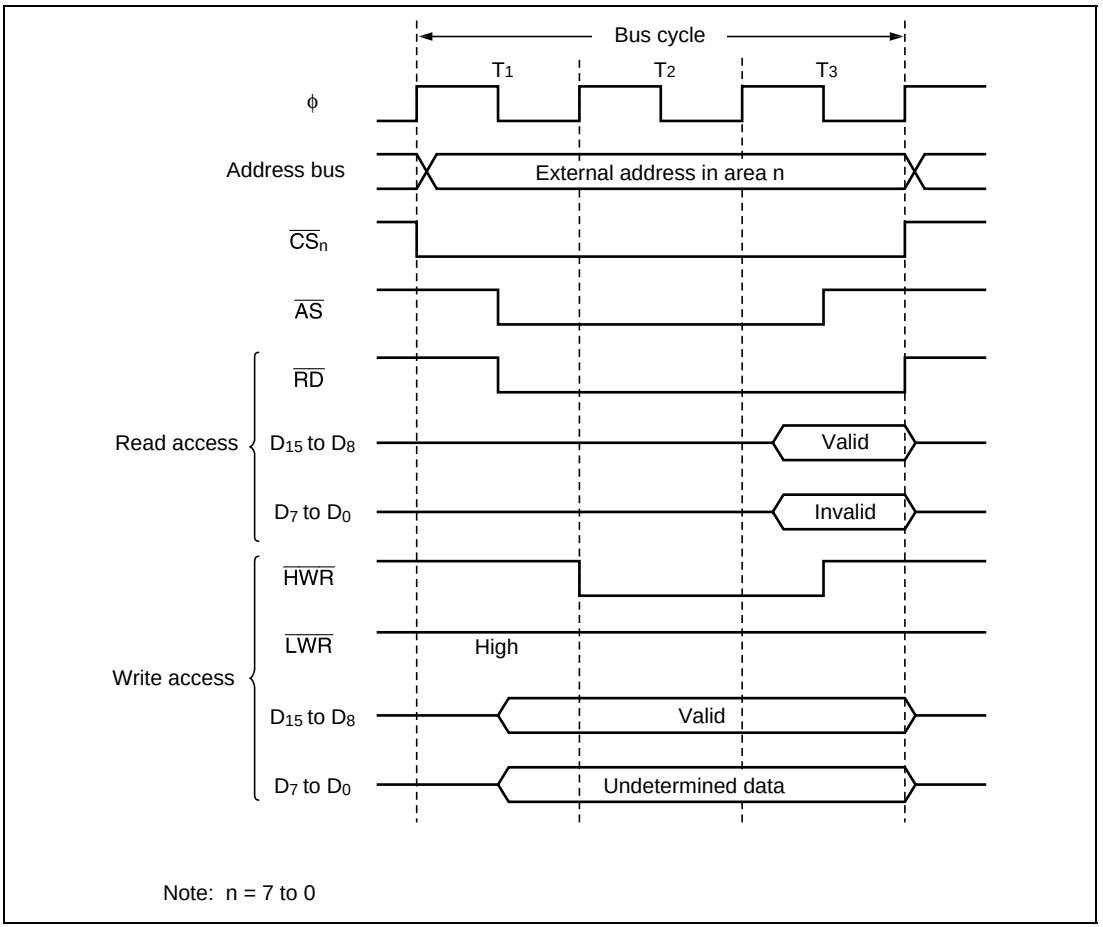


Figure 6.9 Bus Control Signal Timing for 8-Bit, Three-State-Access Area

8-Bit, Two-State-Access Areas

Figure 6.10 shows the timing of bus control signals for an 8-bit, two-state-access area. The upper data bus (D_{15} to D_8) is used in accesses to these areas. The $\overline{LWR}$ pin is always high. Wait states cannot be inserted.

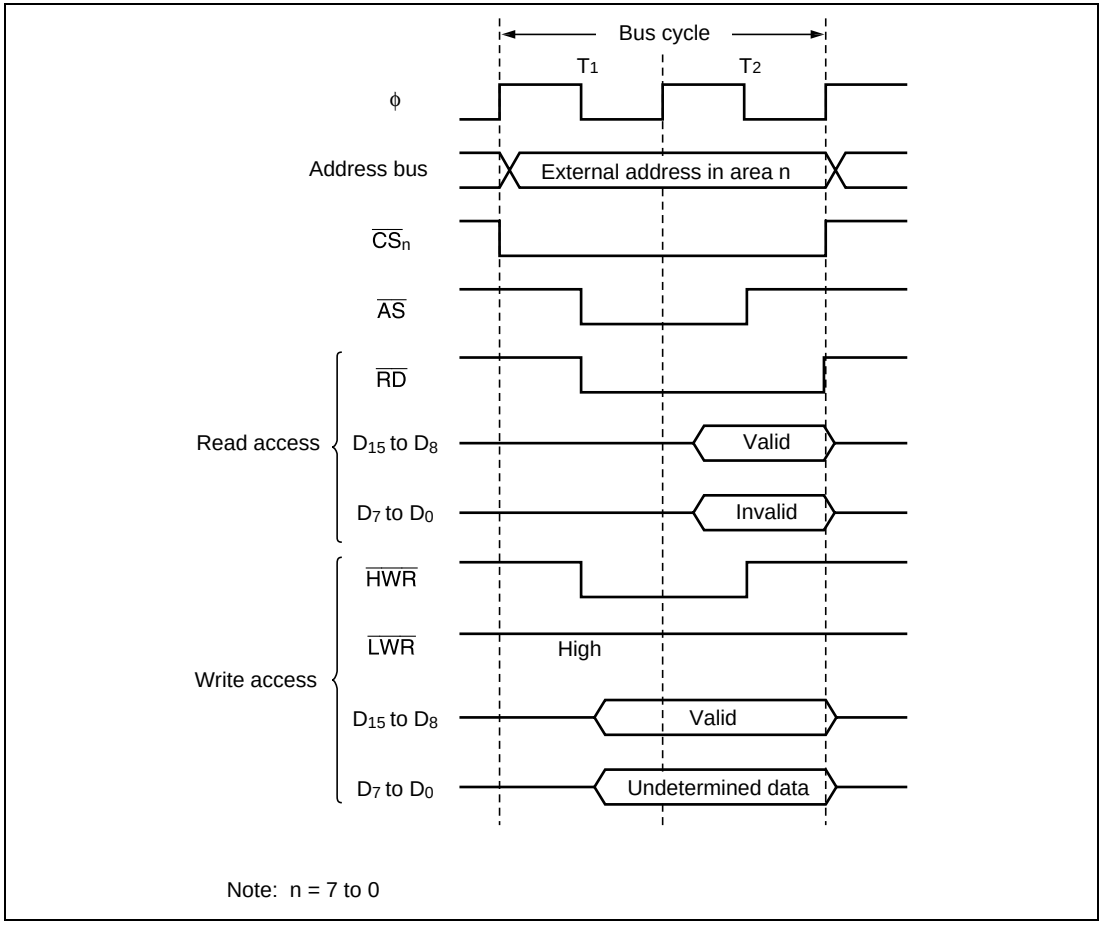


Figure 6.10 Bus Control Signal Timing for 8-Bit, Two-State-Access Area

16-Bit, Three-State-Access Areas

Figures 6.11 to 6.13 show the timing of bus control signals for a 16-bit, three-state-access area. In these areas, the upper data bus (D_{15} to D_8) is used in accesses to even addresses and the lower data bus (D_7 to D_0) in accesses to odd addresses. Wait states can be inserted.

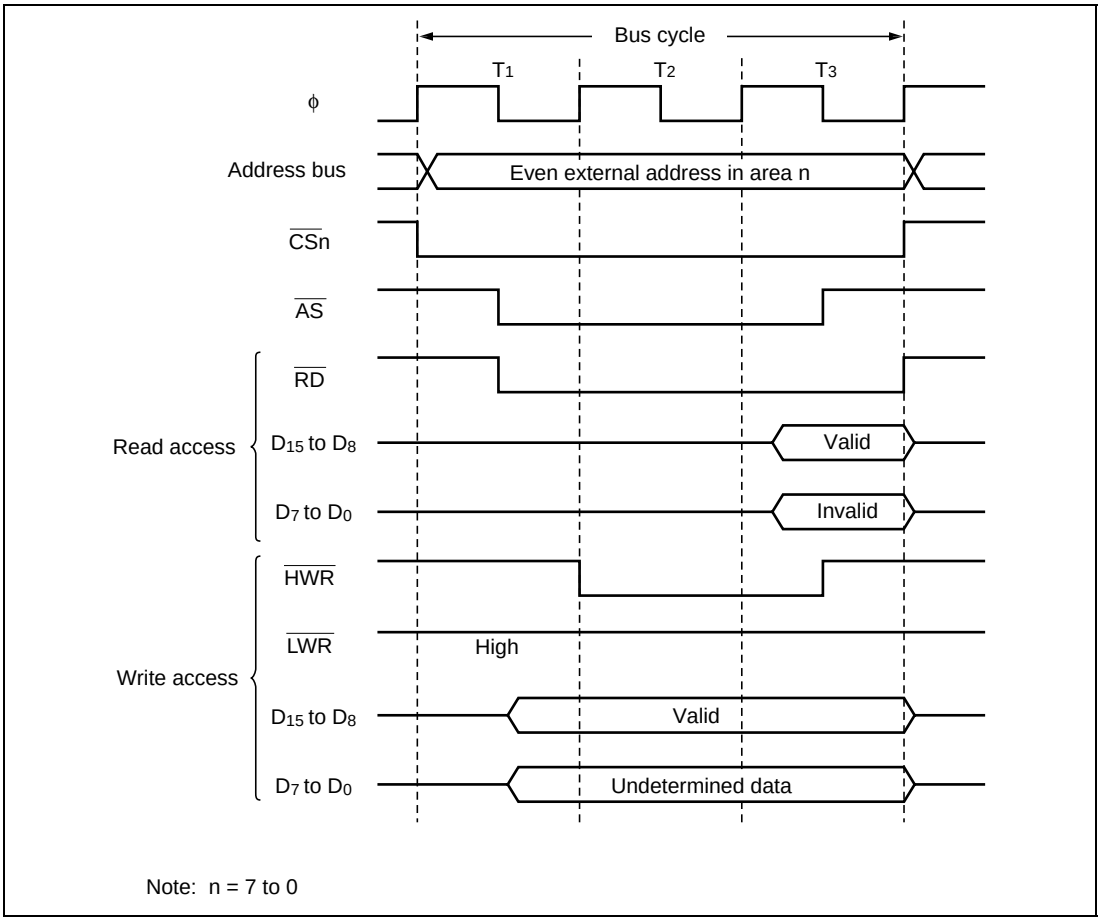


Figure 6.11 Bus Control Signal Timing for 16-Bit, Three-State-Access Area (1) (Byte Access to Even Address)

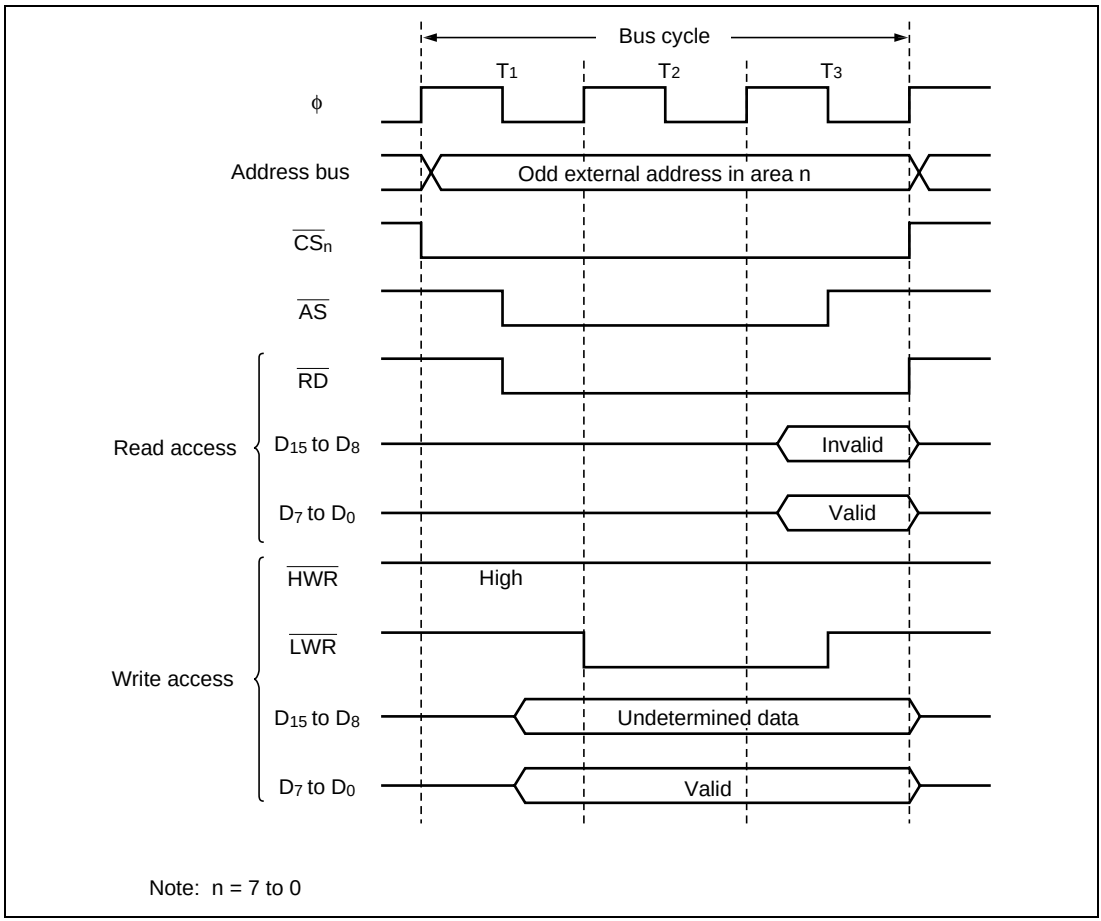


Figure 6.12 Bus Control Signal Timing for 16-Bit, Three-State-Access Area (2) (Byte Access to Odd Address)

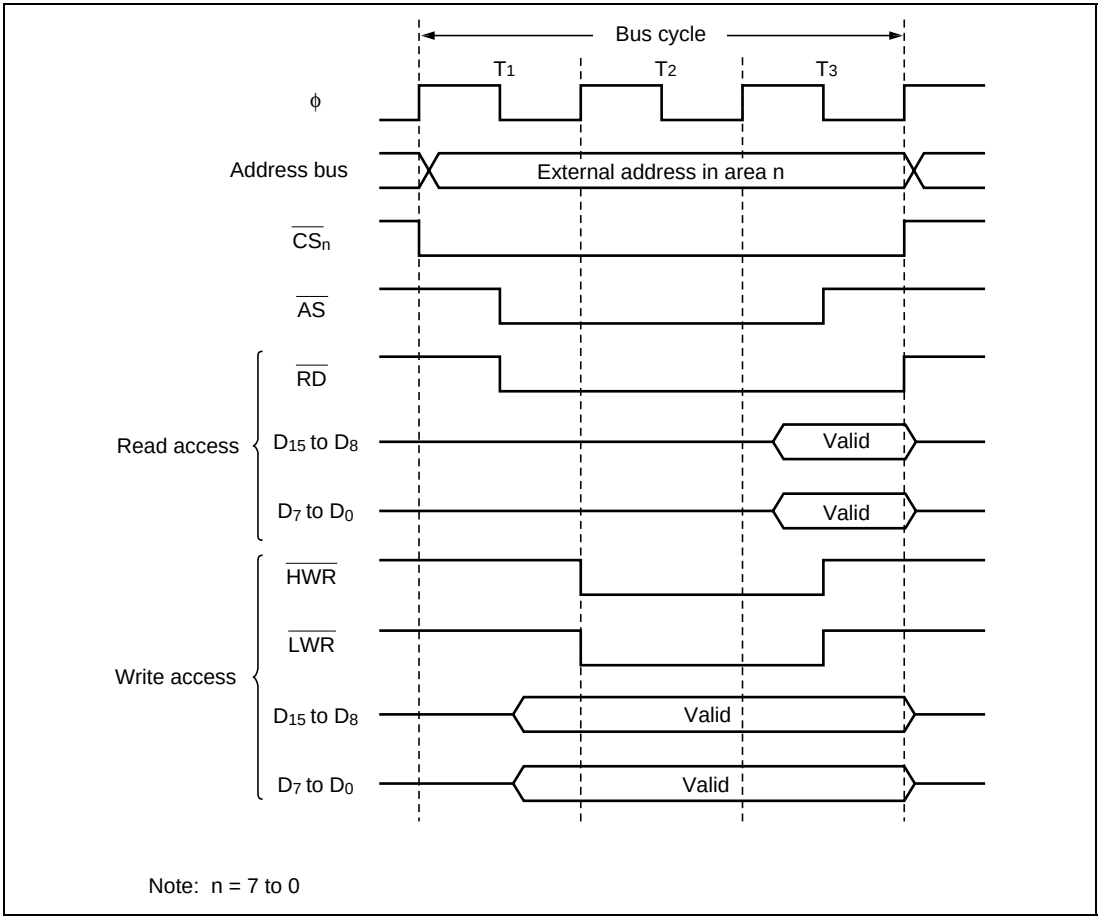


Figure 6.13 Bus Control Signal Timing for 16-Bit, Three-State-Access Area (3) (Word Access)

16-Bit, Two-State-Access Areas: Figures 6.14 to 6.16 show the timing of bus control signals for a 16-bit, two-state-access area. In these areas, the upper data bus (D_{15} to D_8) is used in accesses to even addresses and the lower data bus (D_7 to D_0) in accesses to odd addresses. Wait states cannot be inserted.

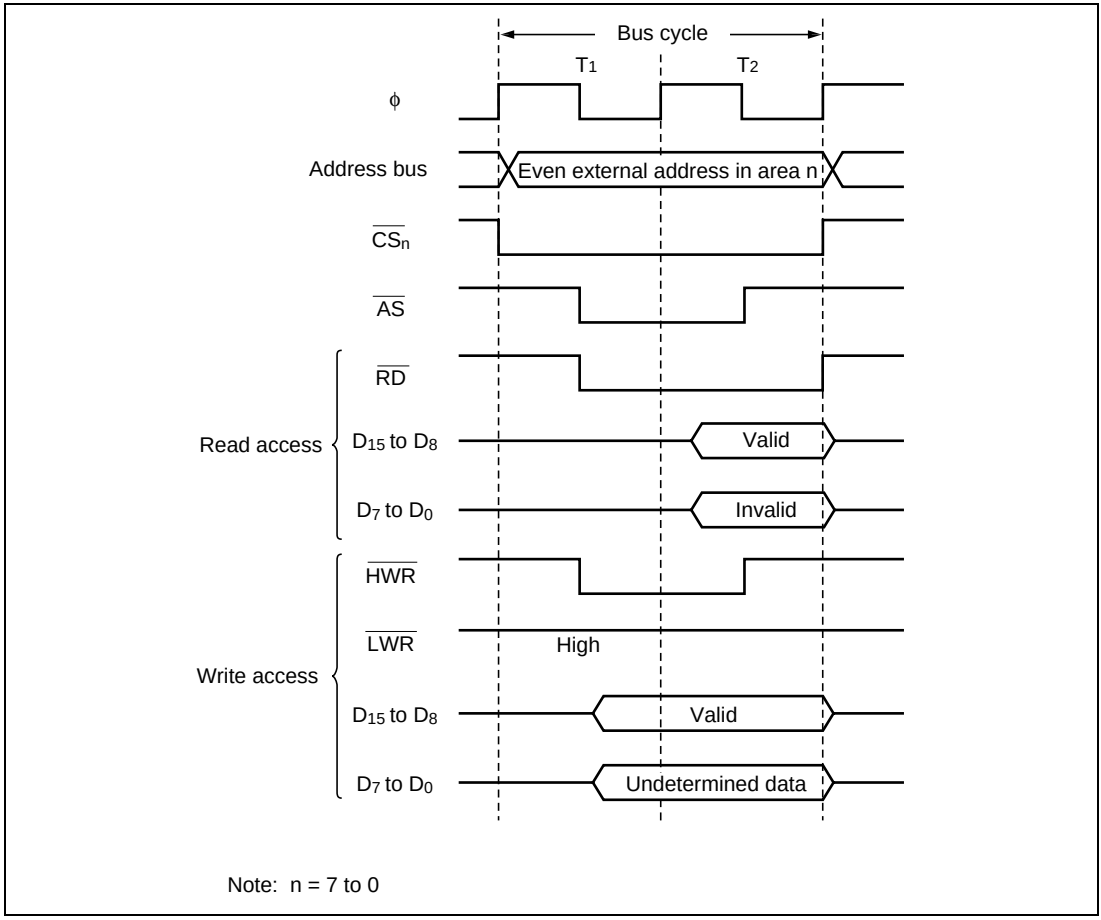


Figure 6.14 Bus Control Signal Timing for 16-Bit, Two-State-Access Area (1) (Byte Access to Even Address)

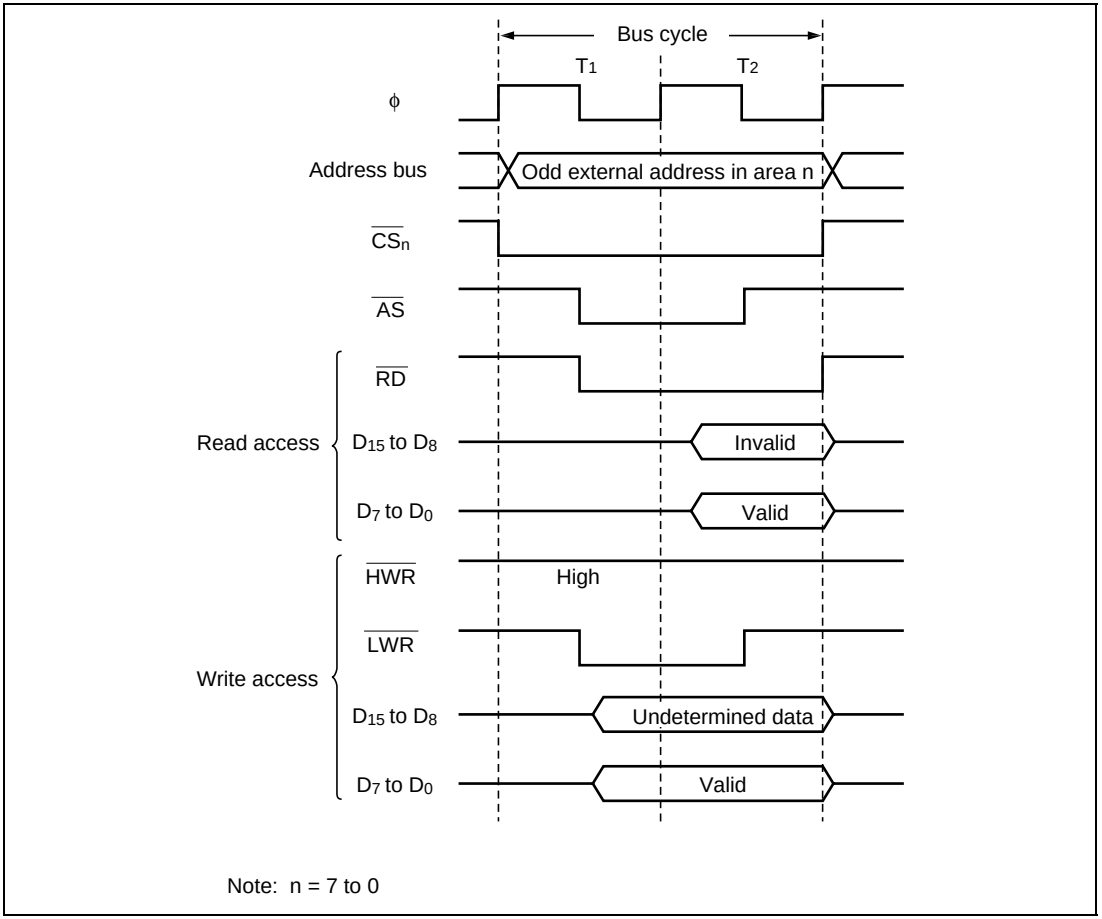


Figure 6.15 Bus Control Signal Timing for 16-Bit, Two-State-Access Area (2) (Byte Access to Odd Address)

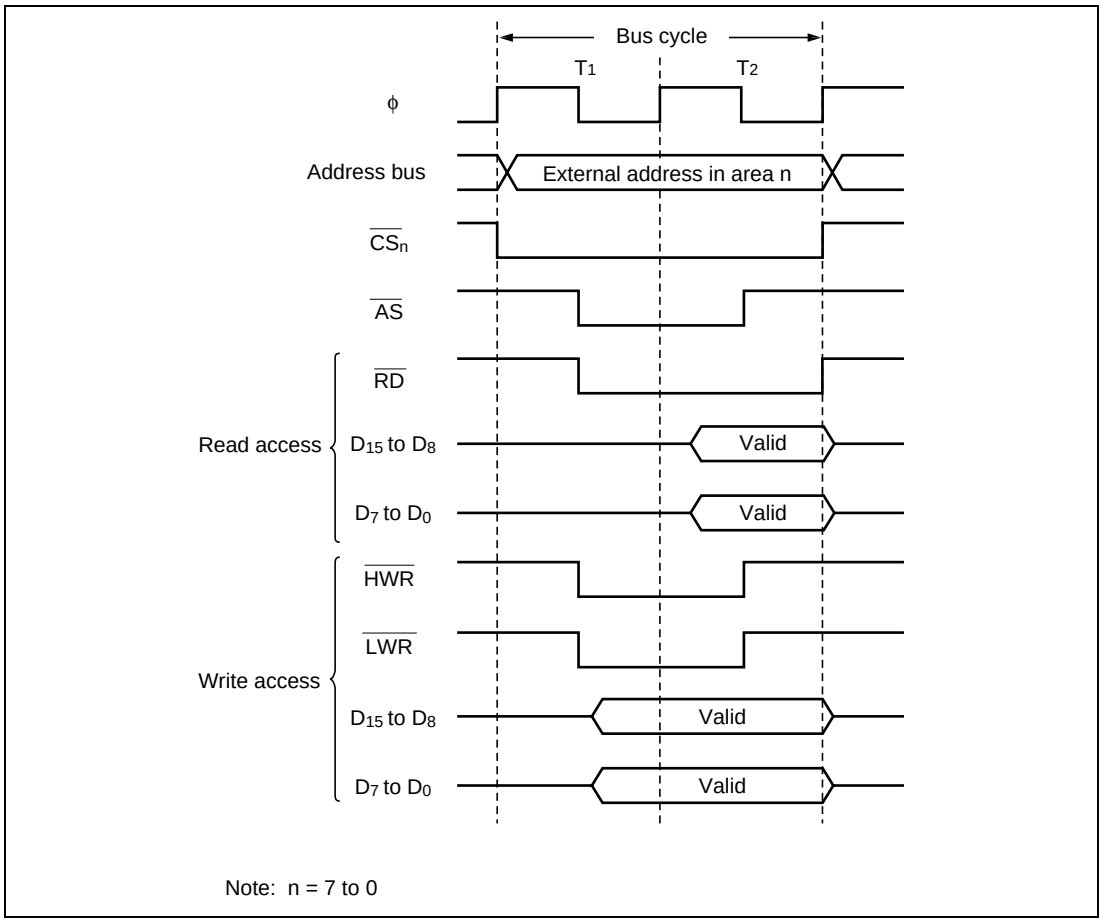


Figure 6.16 Bus Control Signal Timing for 16-Bit, Two-State-Access Area (3) (Word Access)

6.4.6 Wait Control

When accessing external space, the H8/3069R can extend the bus cycle by inserting one or more wait states (T_w). There are two ways of inserting wait states: (1) program wait insertion and (2) pin wait insertion using the $\overline{\text{WAIT}}$ pin.

Program Wait Insertion: From 0 to 3 wait states can be inserted automatically between the T_2 state and T_3 state on an individual area basis in three-state access space, according to the settings of WCRH and WCRL.

Pin Wait Insertion: Setting the WAITE bit in BCR to 1 enables wait insertion by means of the $\overline{\text{WAIT}}$ pin. When external space is accessed in this state, a program wait is first inserted. If the $\overline{\text{WAIT}}$ pin is low at the falling edge of φ in the last T_2 or T_w state, another T_w state is inserted. If the $\overline{\text{WAIT}}$ pin is held low, T_w states are inserted until it goes high.

This is useful when inserting four or more T_w states, or when changing the number of T_w states for different external devices.

The WAITE bit setting applies to all areas. Pin waits cannot be inserted in DRAM space.

Figure 6.17 shows an example of the timing for insertion of one program wait state in 3-state space.

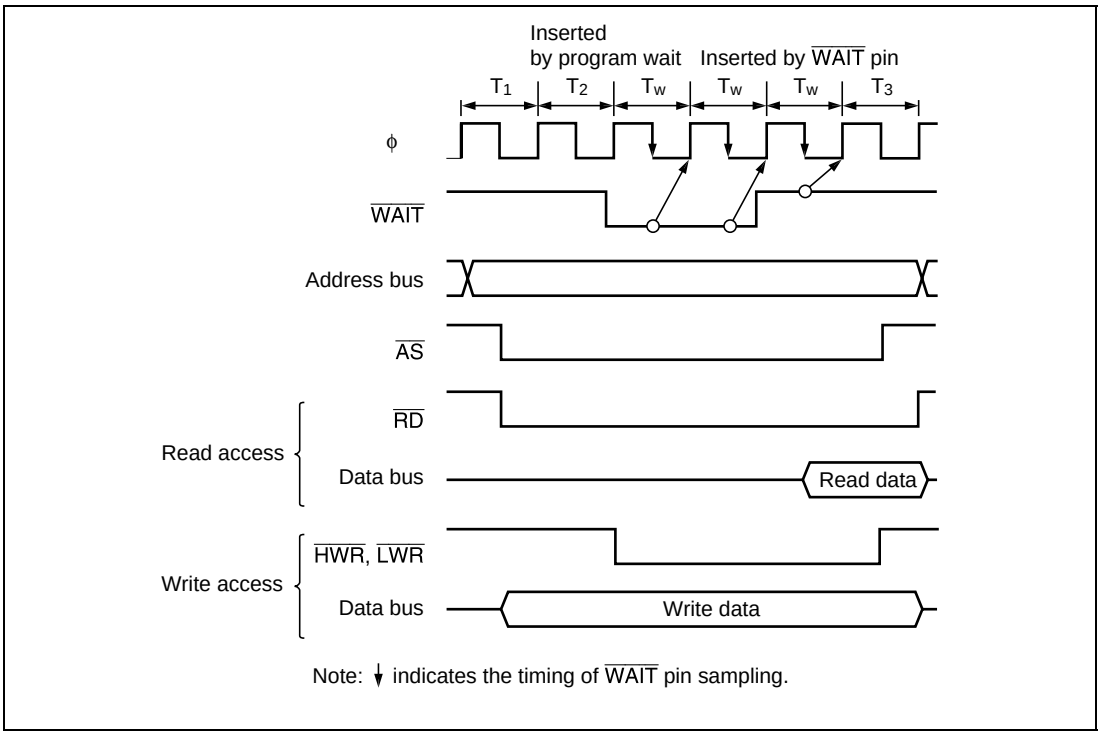


Figure 6.17 Example of Wait State Insertion Timing

6.5 DRAM Interface

6.5.1 Overview

The H8/3069R is provided with a DRAM interface with functions for DRAM control signal ($\overline{\text{RAS}}$, $\overline{\text{UCAS}}$, $\overline{\text{LCAS}}$, $\overline{\text{WE}}$) output, address multiplexing, and refreshing, that direct connection of DRAM. In the expanded modes, external address space areas 2 to 5 can be designated as DRAM space accessed via the DRAM interface. A data bus width of 8 or 16 bits can be selected for DRAM space by means of a setting in ABWCR. When a 16-bit data bus width is selected, CAS is used for byte access control. In the case of × 16-bit organization DRAM, therefore, the 2-CAS type can be connected. A fast page mode is supported in addition to the normal read and write access modes.

6.5.2 DRAM Space and $\overline{\text{RAS}}$ Output Pin Settings

Designation of areas 2 to 5 as DRAM space, and selection of the $\overline{\text{RAS}}$ output pin for each area designated as DRAM space, is performed by setting bits in DRCRA. Table 6.5 shows the correspondence between the settings of bits DRAS2 to DRAS0 and the selected DRAM space and $\overline{\text{RAS}}$ output pin.

When an arbitrary value has been set in DRAS2 to DRAS0, a write of a different value other than 000 must not be performed.

Table 6.5 Settings of Bits DRAS2 to DRAS0 and Corresponding DRAM Space ($\overline{RAS}$ Output Pin)

DRAS2	DRAS1	DRAS0	Area 5	Area 4	Area 3	Area 2
0	0	0	Normal space	Normal space	Normal space	Normal space
		1	Normal space	Normal space	Normal space	DRAM space ($\overline{CS}_2$)
	1	0	Normal space	Normal space	DRAM space ($\overline{CS}_3$)	DRAM space ($\overline{CS}_2$)
		1	Normal space	Normal space	DRAM space ($\overline{CS}_2$)*	DRAM space ($\overline{CS}_2$)*
1	0	0	Normal space	DRAM space ($\overline{CS}_4$)	DRAM space ($\overline{CS}_3$)	DRAM space ($\overline{CS}_2$)
		1	DRAM space ($\overline{CS}_5$)	DRAM space ($\overline{CS}_4$)	DRAM space ($\overline{CS}_3$)	DRAM space ($\overline{CS}_2$)
	1	0	DRAM space ($\overline{CS}_4$)*	DRAM space ($\overline{CS}_4$)*	DRAM space ($\overline{CS}_2$)*	DRAM space ($\overline{CS}_2$)*
		1	DRAM space ($\overline{CS}_2$)*	DRAM space ($\overline{CS}_2$)*	DRAM space ($\overline{CS}_2$)*	DRAM space ($\overline{CS}_2$)*

Note: * A single $\overline{CS}_n$ pin serves as a common $\overline{RAS}$ output pin for a number of areas. Unused $\overline{CS}_n$ pins can be used as input/output ports.

6.5.3 Address Multiplexing

When DRAM space is accessed, the row address and column address are multiplexed. The address multiplexing method is selected with bits MXC1 and MXC0 in DRCRB according to the number of bits in the DRAM column address. Table 6.6 shows the correspondence between the settings of MXC1 and MXC0 and the address multiplexing method.

Table 6.6 Settings of Bits MXC1 and MXC0 and Address Multiplexing Method

	DRCRB		Column Address	Address Pins													
	MXC1	MXC0	Bits	A_{23} to A_{13}	A_{12}	A_{11}	A_{10}	A_9	A_8	A_7	A_6	A_5	A_4	A_3	A_2	A_1	A_0
Row address	0	0	8 bits	A_{23} to A_{13}	A_{20}*	A_{19}	A_{18}	A_{17}	A_{16}	A_{15}	A_{14}	A_{13}	A_{12}	A_{11}	A_{10}	A_9	A_8
		1	9 bits	A_{23} to A_{13}	A_{12}	A_{20}*	A_{19}	A_{18}	A_{17}	A_{16}	A_{15}	A_{14}	A_{13}	A_{12}	A_{11}	A_{10}	A_9
	1	0	10 bits	A_{23} to A_{13}	A_{12}	A_{11}	A_{20}*	A_{19}	A_{18}	A_{17}	A_{16}	A_{15}	A_{14}	A_{13}	A_{12}	A_{11}	A_{10}
		1	Illegal setting	—	—	—	—	—	—	—	—	—	—	—	—	—	—
Column address	—	—	—	A_{23} to A_{13}	A_{12}	A_{11}	A_{10}	A_9	A_8	A_7	A_6	A_5	A_4	A_3	A_2	A_1	A_0

Note: * Row address bit A_{20} is not multiplexed in 1-Mbyte mode.

6.5.4 Data Bus

If the bit in ABWCR corresponding to an area designated as DRAM space is set to 1, that area is designated as 8-bit DRAM space; if the bit is cleared to 0, the area is designated as 16-bit DRAM space. In 16-bit DRAM space, × 16-bit organization DRAM can be connected directly.

In 8-bit DRAM space the upper half of the data bus, D_{15} to D_8, is enabled, while in 16-bit DRAM space both the upper and lower halves of the data bus, D_{15} to D_0, are enabled.

Access sizes and data alignment are the same as for the basic bus interface: see section 6.4.2, Data Size and Data Alignment.

6.5.5 Pins Used for DRAM Interface

Table 6.7 shows the pins used for DRAM interfacing and their functions.

Table 6.7 DRAM Interface Pins

Pin	With DRAM Designated	Name	I/O	Function
PB4	$\overline{UCAS}$	Upper column address strobe	Output	Upper column address strobe for DRAM space access (when CSEL = 0 in DRCRB)
PB5	$\overline{LCAS}$	Lower column address strobe	Output	Lower column address strobe for DRAM space access (when CSEL = 0 in DRCRB)
$\overline{HWR}$	$\overline{UCAS}$	Upper column address strobe	Output	Upper column address strobe for DRAM space access (when CSEL = 1 in DRCRB)
$\overline{LWR}$	$\overline{LCAS}$	Lower column address strobe	Output	Lower column address strobe for DRAM space access (when CSEL = 1 in DRCRB)
$\overline{CS_2}$	$\overline{RAS_2}$	Row address strobe 2	Output	Row address strobe for DRAM space access
$\overline{CS_3}$	$\overline{RAS_3}$	Row address strobe 3	Output	Row address strobe for DRAM space access
$\overline{CS_4}$	$\overline{RAS_4}$	Row address strobe 4	Output	Row address strobe for DRAM space access
$\overline{CS_5}$	$\overline{RAS_5}$	Row address strobe 5	Output	Row address strobe for DRAM space access
$\overline{RD}$	$\overline{WE}$	Write enable	Output	Write enable for DRAM space write access*
P80	$\overline{RFSH}$	Refresh	Output	Goes low in refresh cycle
A_{12} to A_0	A_{12} to A_0	Address	Output	Row address/column address multiplexed output
D_{15} to D_0	D_{15} to D_0	Data	I/O	Data input/output pins

Note: * Fixed high in a read access.

6.5.6 Basic Timing

Figure 6.18 shows the basic access timing for DRAM space. The basic DRAM access timing is four states: one precharge cycle (T_p) state, one row address output cycle (T_r) state, and two column address output cycle (T_{c1}, T_{c2}) states. Unlike the basic bus interface, the corresponding bits in ASTCR control only enabling or disabling of wait insertion between T_{c1} and T_{c2}, and do not affect the number of access states. When the corresponding bit in ASTCR is cleared to 0, wait states cannot be inserted between T_{c1} and T_{c2} in the DRAM access cycle.

If a DRAM read/write cycle is followed by an access cycle for an external area other than DRAM space when $\overline{HWR}$ and $\overline{LWR}$ are selected as the $\overline{UCAS}$ and $\overline{LCAS}$ output pins, an idle cycle (Ti) is inserted unconditionally immediately after the DRAM access cycle. See section 6.9, Idle Cycle, for details.

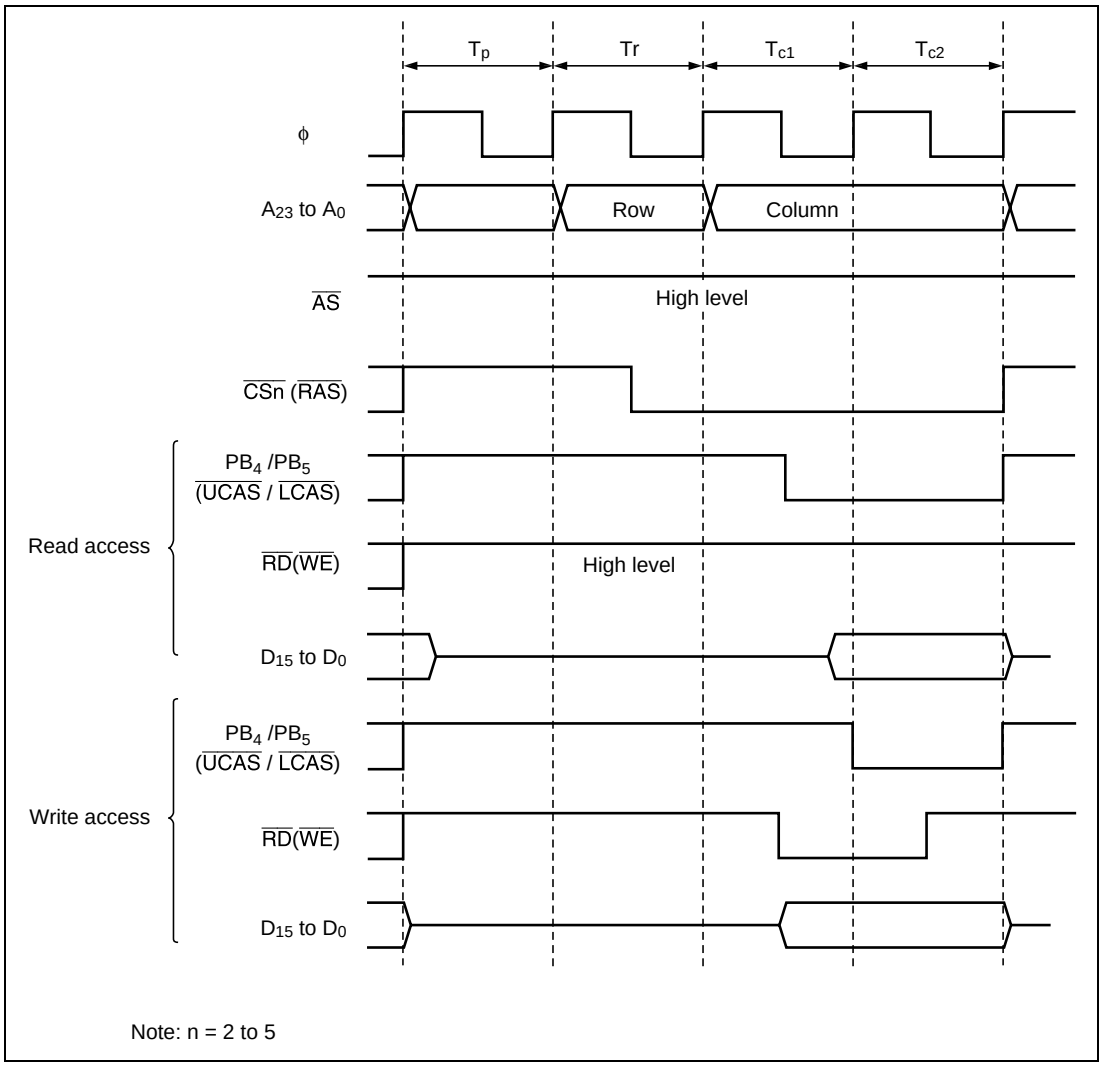


Figure 6.18 Basic Access Timing (CSEL = 0 in DRCRB)

6.5.7 Precharge State Control

In the H8/3069R, provision is made for the DRAM RAS precharge time by always inserting one RAS precharge state (T_p) when DRAM space is accessed. This can be changed to two T_p states by setting the TPC bit to 1 in DRCRB. The optimum number of T_p cycles should be set according to the DRAM connected and the operating frequency of the H8/3069R chip. Figure 6.19 shows the timing when two T_p states are inserted.

When the TCP bit is set to 1, two T_p states are also used for CAS-before-RAS refresh cycles.

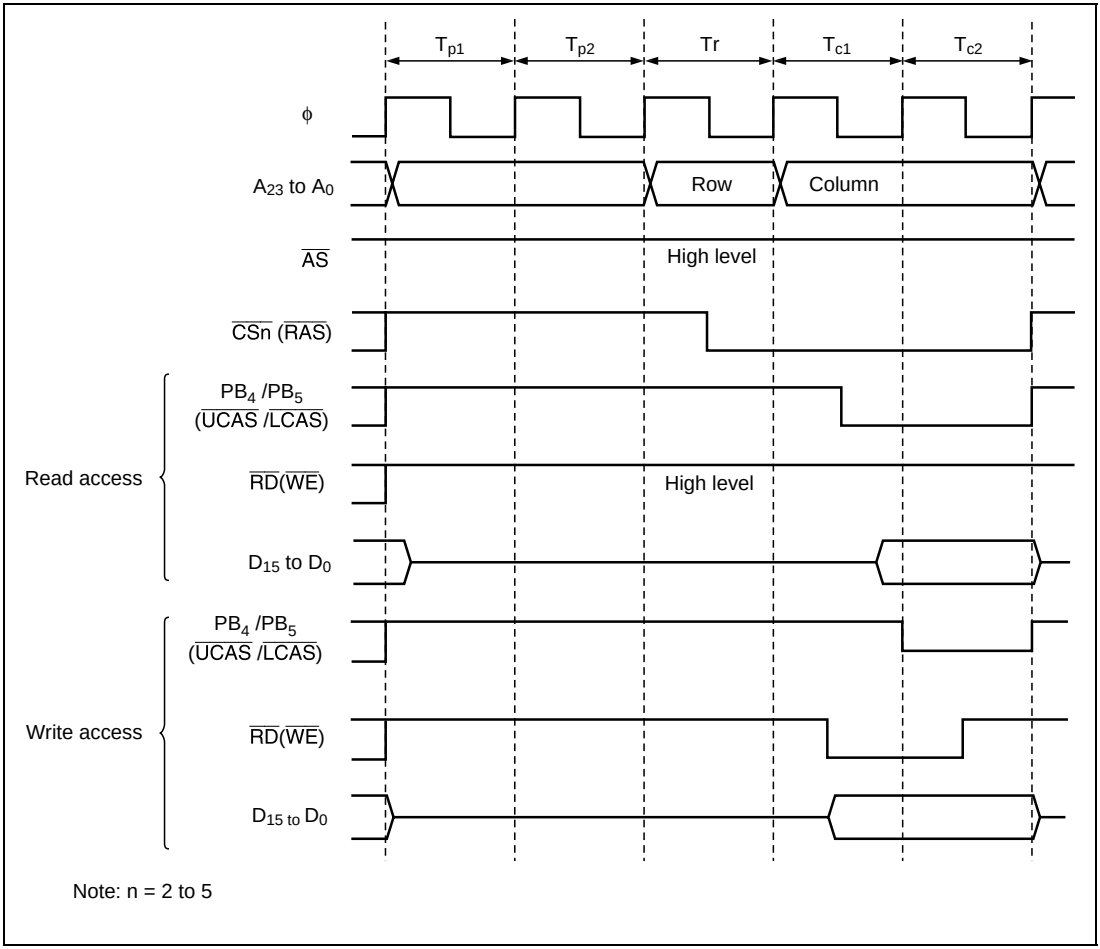


Figure 6.19 Timing with Two Precharge States (CSEL = 0 in DRCRB)

6.5.8 Wait Control

In a DRAM access cycle, wait states can be inserted (1) between the T_r state and T_{c1} state, and (2) between the T_{c1} state and T_{c2} state.

Insertion of T_{rw} Wait State between T_r and T_{c1}: One T_{rw} state can be inserted between T_r and T_{c1} by setting the RCW bit to 1 in DRCRB.

Insertion of T_w Wait State(s) between T_{c1} and T_{c2}: When the bit in ASTCR corresponding to an area designated as DRAM space is set to 1, from 0 to 3 wait states can be inserted between the T_{c1} state and T_{c2} state by means of settings in WCRH and WCRL.

Figure 6.20 shows an example of the timing for wait state insertion.

The settings of the RCW bit in DRCRB and of ASTCR, WCRH, and WCRL do not affect refresh cycles. Wait states cannot be inserted in a DRAM space access cycle by means of the $\overline{\text{WAIT}}$ pin.

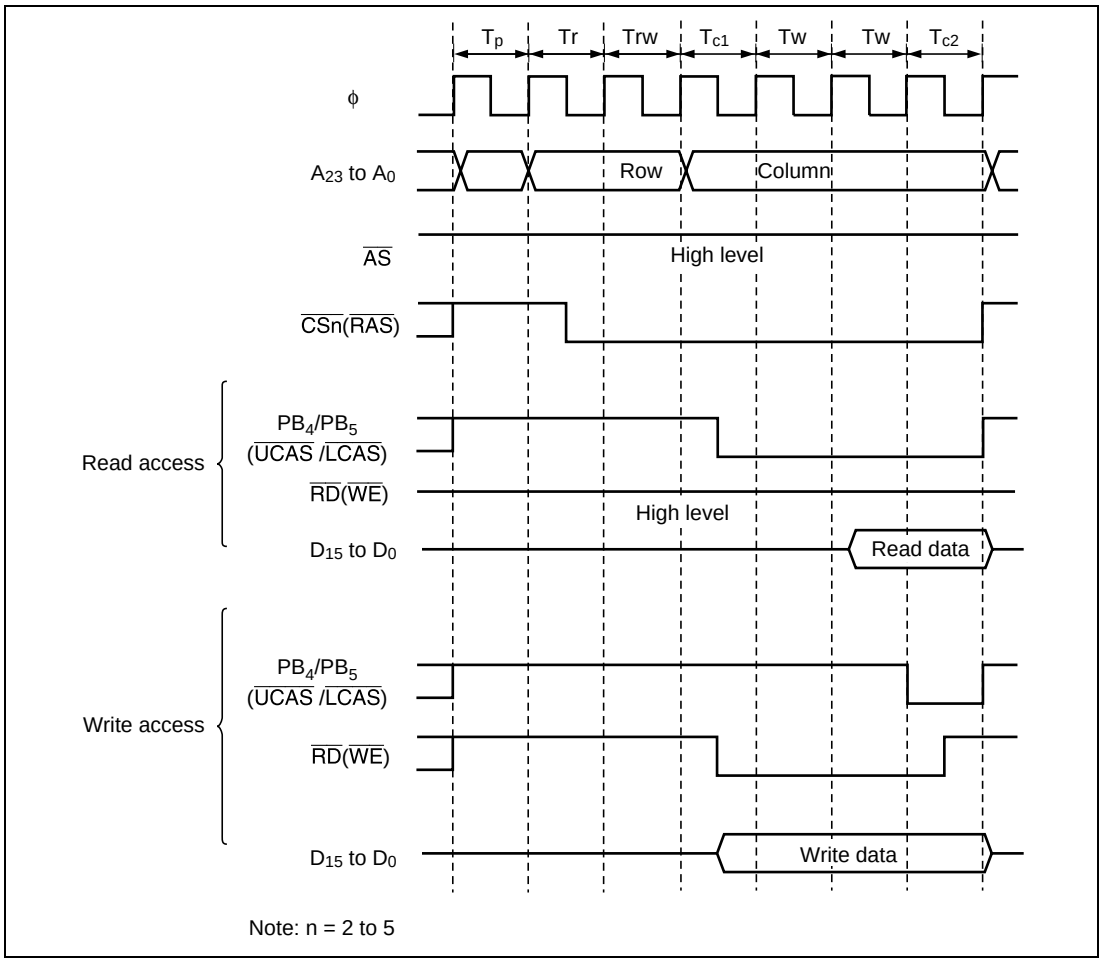


Figure 6.20 Example of Wait State Insertion Timing (CSEL = 0)

6.5.9 Byte Access Control and $\overline{\text{CAS}}$ Output Pin

When an access is made to DRAM space designated as a 16-bit-access area in ABWCR, column address strobes ($\overline{\text{UCAS}}$ and $\overline{\text{LCAS}}$) corresponding to the upper and lower halves of the external data bus are output. In the case of × 16-bit organization DRAM, the 2-CAS type can be connected.

Either PB4 and PB5, or $\overline{\text{HWR}}$ and $\overline{\text{LWR}}$, can be used as the $\overline{\text{UCAS}}$ and $\overline{\text{LCAS}}$ output pins, the selection being made with the CSEL bit in DRCRB. Table 6.8 shows the CSEL bit settings and corresponding output pin selections.

When an access is made to DRAM space designated as an 8-bit-access area in ABWCR, only $\overline{\text{UCAS}}$ is output. When the entire DRAM space is designated as 8-bit-access space and CSEL = 0, PB5 can be used as an input/output port.

Note that $\overline{\text{RAS}}$ down mode cannot be used when a device other than DRAM is connected to external space and $\overline{\text{HWR}}$ and $\overline{\text{LWR}}$ are used as write strobes. In this case, also, an idle cycle (Ti) is always inserted when an external access to other than DRAM space occurs after a DRAM space access. For details, see section 6.9, Idle Cycle.

Table 6.8 CSEL Settings and $\overline{\text{UCAS}}$ and $\overline{\text{LCAS}}$ Output Pins

CSEL	$\overline{\text{UCAS}}$	$\overline{\text{LCAS}}$
0	PB_4	PB_5
1	$\overline{\text{HWR}}$	$\overline{\text{LWR}}$

Figure 6.21 shows the control timing.

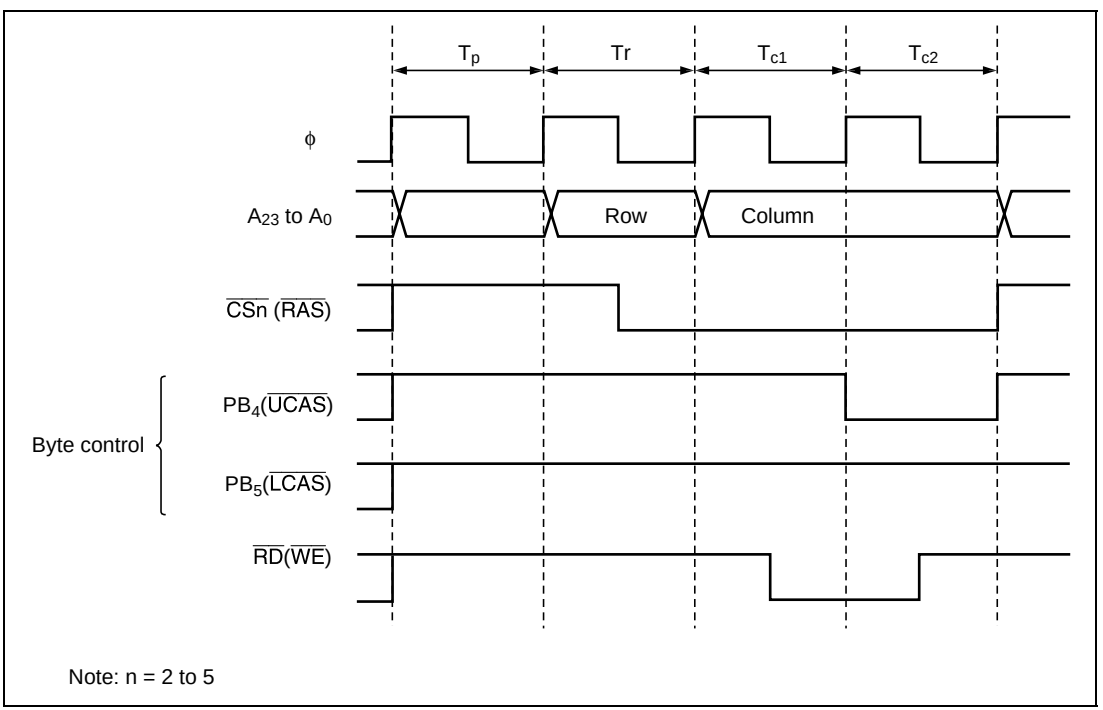


Figure 6.21 Control Timing (Upper-Byte Write Access When CSEL = 0)

6.5.10 Burst Operation

With DRAM, in addition to full access (normal access) in which data is accessed by outputting a row address for each access, a fast page mode is also provided which can be used when making a number of consecutive accesses to the same row address. This mode enables fast (burst) access of data by simply changing the column address after the row address has been output. Burst access can be selected by setting the BE bit to 1 in DRCRA.

Burst Access (Fast Page Mode) Operation Timing: Figure 6.22 shows the operation timing for burst access. When there are consecutive access cycles for DRAM space, the column address and $\overline{CAS}$ signal output cycles (two states) continue as long as the row address is the same for consecutive access cycles. In burst access, too, the bus cycle can be extended by inserting wait states between T_{c1} and T_{c2}. The wait state insertion method and timing are the same as for full access: see section 6.5.8, Wait Control, for details.

The row address used for the comparison is determined by the bus width of the relevant area set in bits MXC1 and MXC0 in DRCRB, and in ABWCR. Table 6.9 shows the compared row addresses corresponding to the various settings of bits MXC1 and MXC0, and ABWCR.

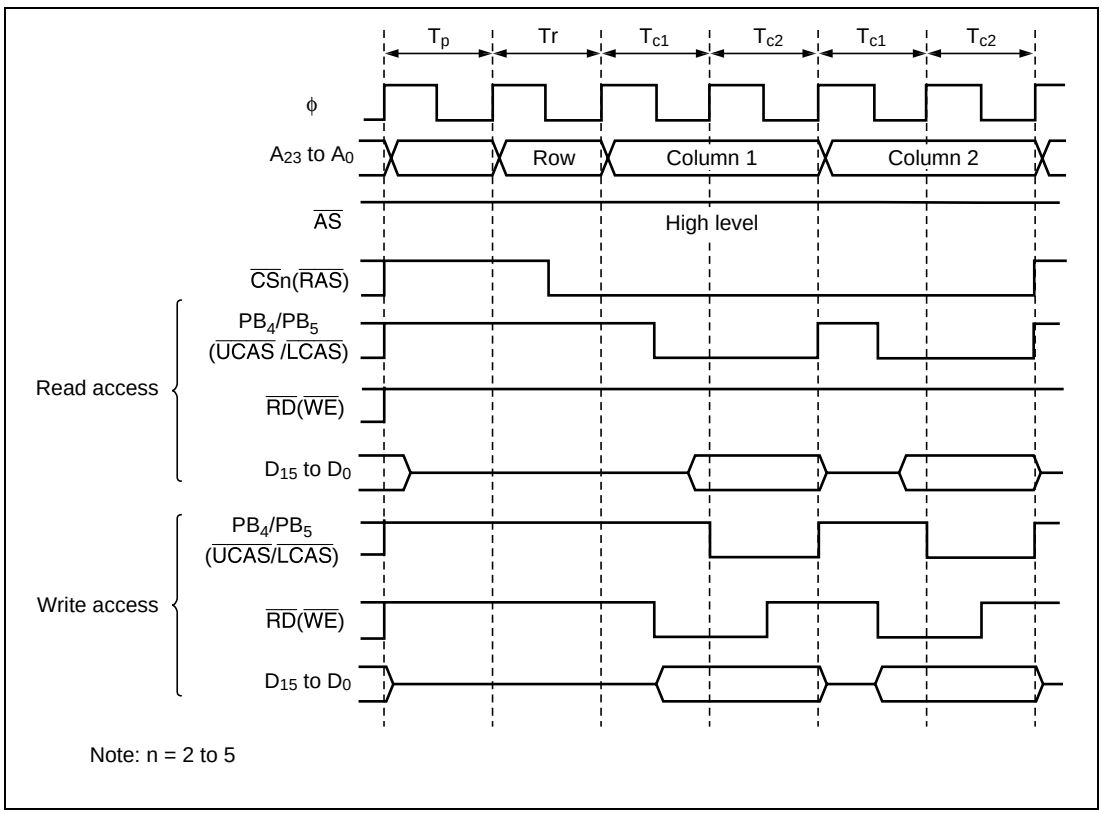


Figure 6.22 Operation Timing in Fast Page Mode

Table 6.9 Correspondence between Settings of MXC1 and MXC0 Bits and ABWCR, and Row Address Compared in Burst Access

	DRCRB		ABWCR		
Operating Mode	**MXC1**	**MXC0**	**ABWn**	**Bus Width**	**Compared Row Address**
Modes 1 and 2 (1-Mbyte)	0	0	0	16 bits	A19 to A9
			1	8 bits	A19 to A8
		1	0	16 bits	A19 to A10
			1	8 bits	A19 to A9
	1	0	0	16 bits	A19 to A11
			1	8 bits	A19 to A10
		1	—	—	Illegal setting
Modes 3, 4, and 5 (16-Mbyte)	0	0	0	16 bits	A23 to A9
			1	8 bits	A23 to A8
		1	0	16 bits	A23 to A10
			1	8 bits	A23 to A9
	1	0	0	16 bits	A23 to A11
			1	8 bits	A23 to A10
		1	—	—	Illegal setting

Note: n = 2 to 5

RAS Down Mode and RAS Up Mode: With DRAM provided with fast page mode, as long as accesses are to the same row address, burst operation can be continued without interruption even if accesses are not consecutive by holding the $\overline{\text{RAS}}$ signal low.

- RAS Down Mode

  To select RAS down mode, set the BE and RDM bits to 1 in DRCRA. If access to DRAM space is interrupted and another space is accessed, the $\overline{\text{RAS}}$ signal is held low during the access to the other space, and burst access is performed if the row address of the next DRAM space access is the same as the row address of the previous DRAM space access. Figure 6.23 shows an example of the timing in RAS down mode.

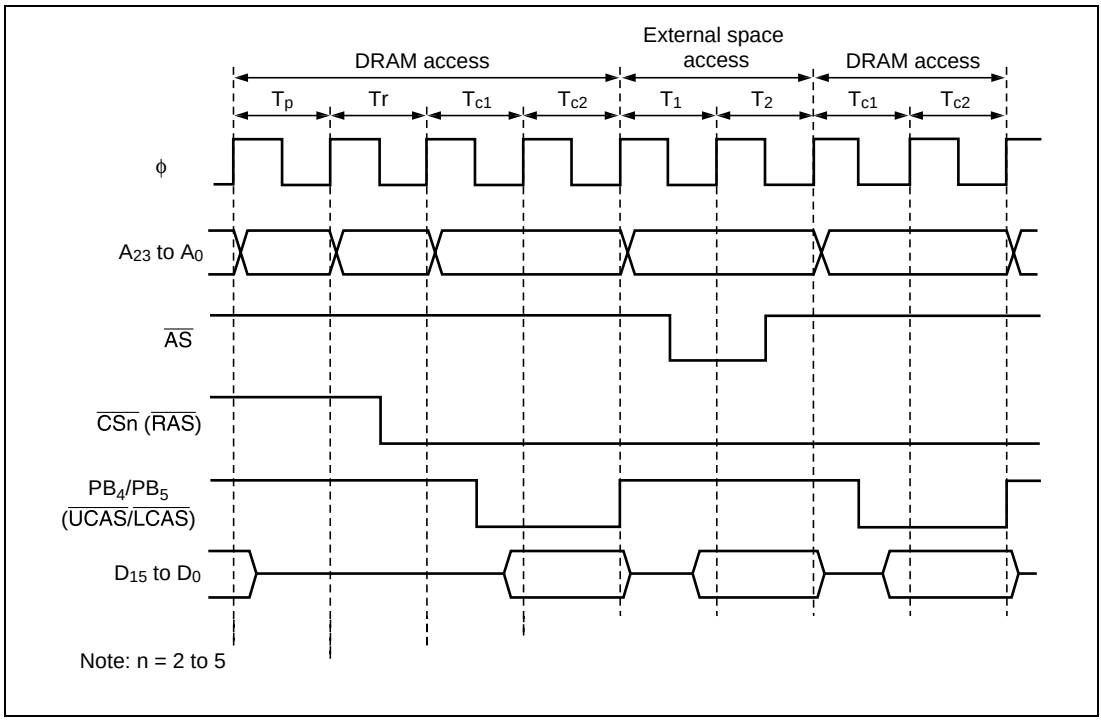


Figure 6.23 Example of Operation Timing in RAS Down Mode (CSEL = 0)

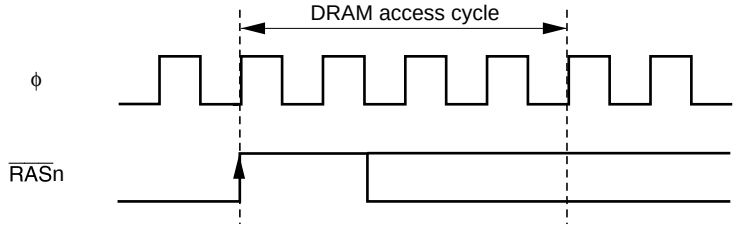
When RAS down mode is selected, the conditions for an asserted $\overline{\text{RAS}}$n signal to return to the high level are as shown below. The timing in these cases is shown in figure 6.24.

— When DRAM space with a different row address is accessed

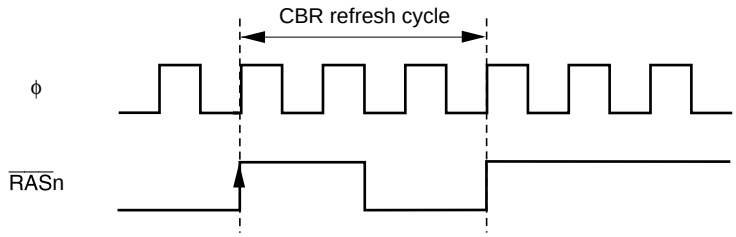
— Immediately before a CAS-before-RAS refresh cycle

— When the BE bit or RDM bit is cleared to 0 in DRCRA

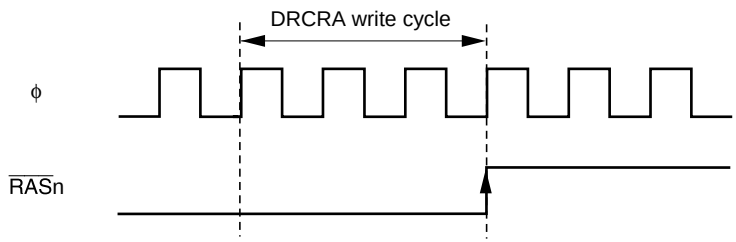
— Immediately before release of the external bus



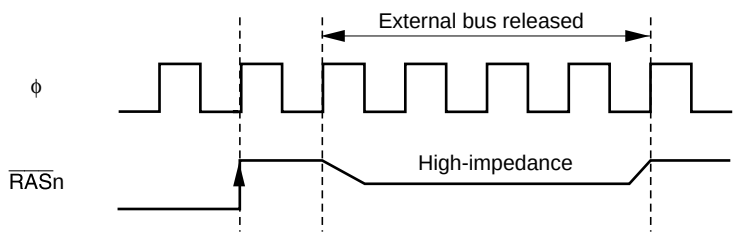
(a) Access to DRAM space with a different row address



(b) CAS-before-RAS refresh cycle



(c) BE bit or RDM bit cleared to 0 in DRCRA



(d) External bus released

Note: n = 2 to 5

Figure 6.24 $\overline{\text{RAS}}$n Negation Timing when RAS Down Mode is Selected

When RAS down mode is selected, the CAS-before-RAS refresh function provided with this DRAM interface must always be used as the DRAM refreshing method. When a refresh operation is performed, the $\overline{RAS}$ signal goes high immediately beforehand. The refresh interval setting must be made so that the maximum DRAM $\overline{RAS}$ pulse width specification is observed.

When the self-refresh function is used, the RDM bit must be cleared to 0, and RAS up mode selected, before executing a SLEEP instruction in order to enter software standby mode. Select RAS down mode again after exiting software standby mode.

Note that RAS down mode cannot be used when $\overline{HWR}$ and $\overline{LWR}$ are selected for $\overline{UCAS}$ and $\overline{LCAS}$, a device other than DRAM is connected to external space, and $\overline{HWR}$ and $\overline{LWR}$ are used as write strobes.

- RAS Up Mode

  To select RAS up mode, clear the RDM bit to 0 in DRCRA. Each time access to DRAM space is interrupted and another space is accessed, the $\overline{RAS}$ signal returns to the high level. Burst operation is only performed if DRAM space is continuous. Figure 6.25 shows an example of the timing in RAS up mode.

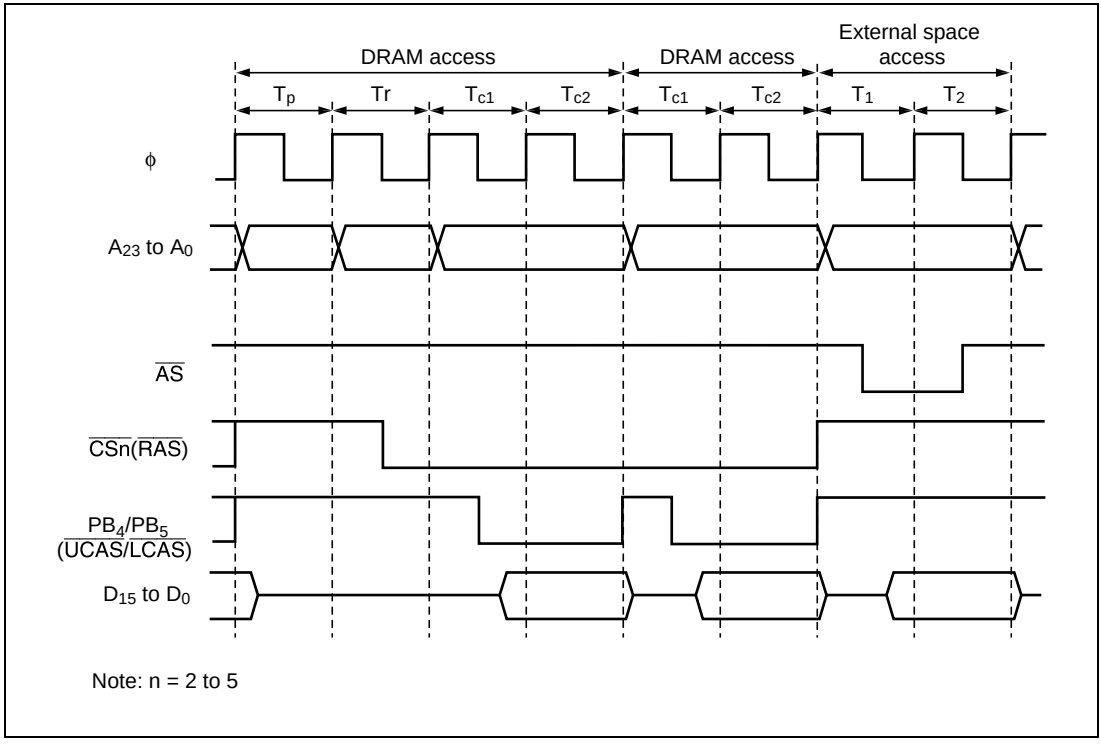


Figure 6.25 Example of Operation Timing in RAS Up Mode

6.5.11 Refresh Control

The H8/3069R is provided with a CAS-before-RAS (CBR) function and self-refresh function as DRAM refresh control functions.

CAS-Before-RAS (CBR) Refreshing: To select CBR refreshing, set the RCYCE bit to 1 in DRCRB.

With CBR refreshing, RTCNT counts up using the input clock selected by bits CKS2 to CKS0 in RTMCSR, and a refresh request is generated when the count matches the value set in RTCOR (compare match). At the same time, RTCNT is reset and starts counting up again from H'00. Refreshing is thus repeated at fixed intervals determined by RTCOR and bits CKS2 to CKS0. A refresh cycle is executed after this refresh request has been accepted and the DRAM interface has acquired the bus. Set a value in bits CKS2 to CKS0 in RTCOR that will meet the refresh interval specification for the DRAM used. When RAS down mode is used, set the refresh interval so that the maximum $\overline{RAS}$ pulse width specification is met.

RTCNT starts counting up when bits CKS2 to CKS0 are set. RTCNT and RTCOR settings should therefore be completed before setting bits CKS2 to CKS0.

Also note that a repeat refresh request generated during a bus request, or a refresh request during refresh cycle execution, will be ignored.

RTCNT operation is shown in figure 6.26, compare match timing in figure 6.27, and CBR refresh timing in figures 6.28 and 6.29.

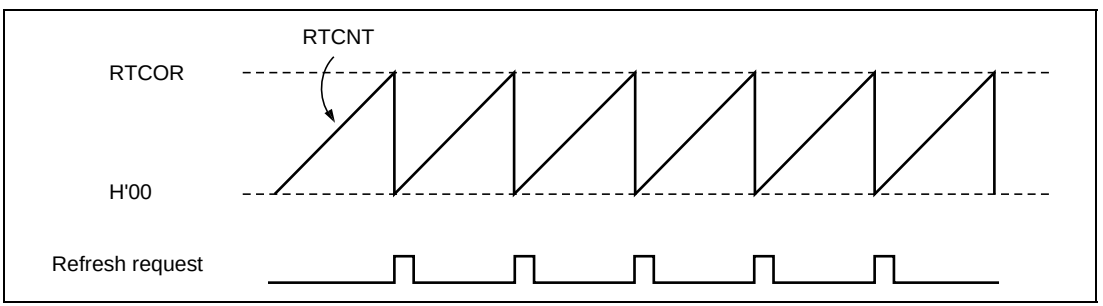


Figure 6.26 RTCNT Operation

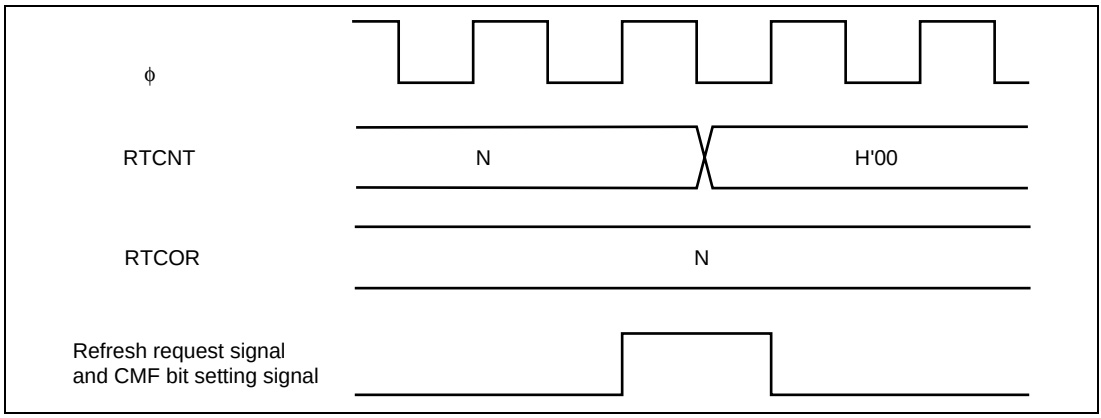
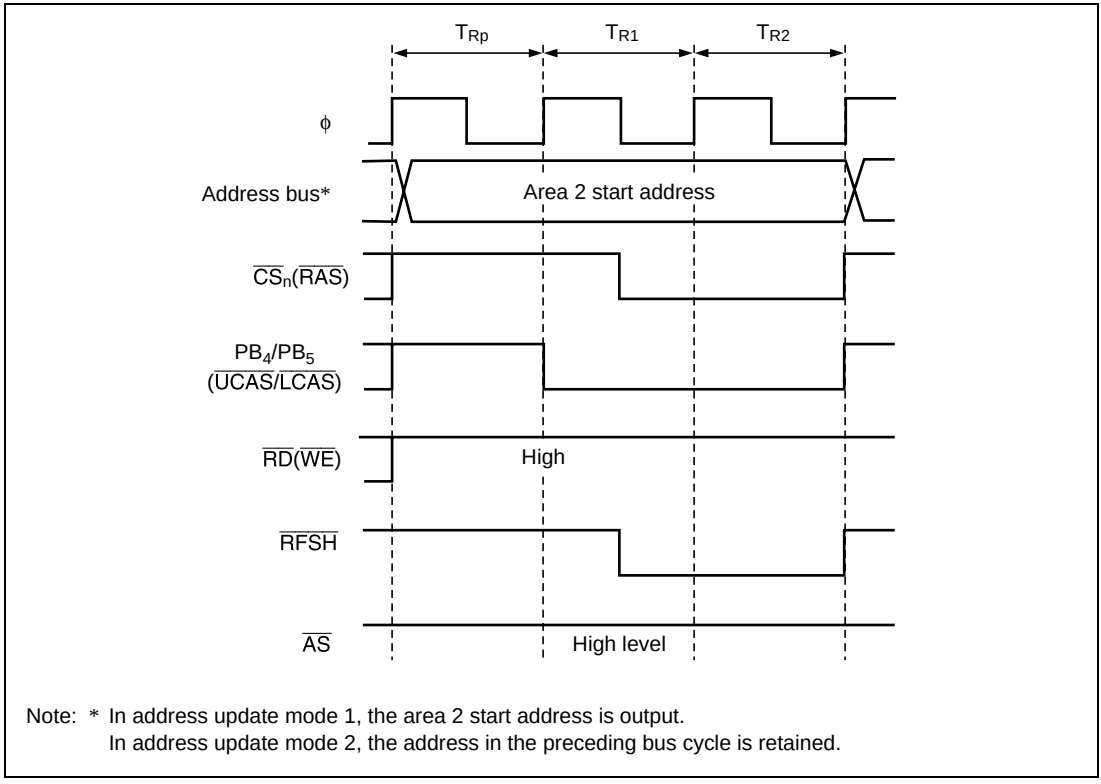


Figure 6.27 Compare Match Timing



Note: * In address update mode 1, the area 2 start address is output.
In address update mode 2, the address in the preceding bus cycle is retained.

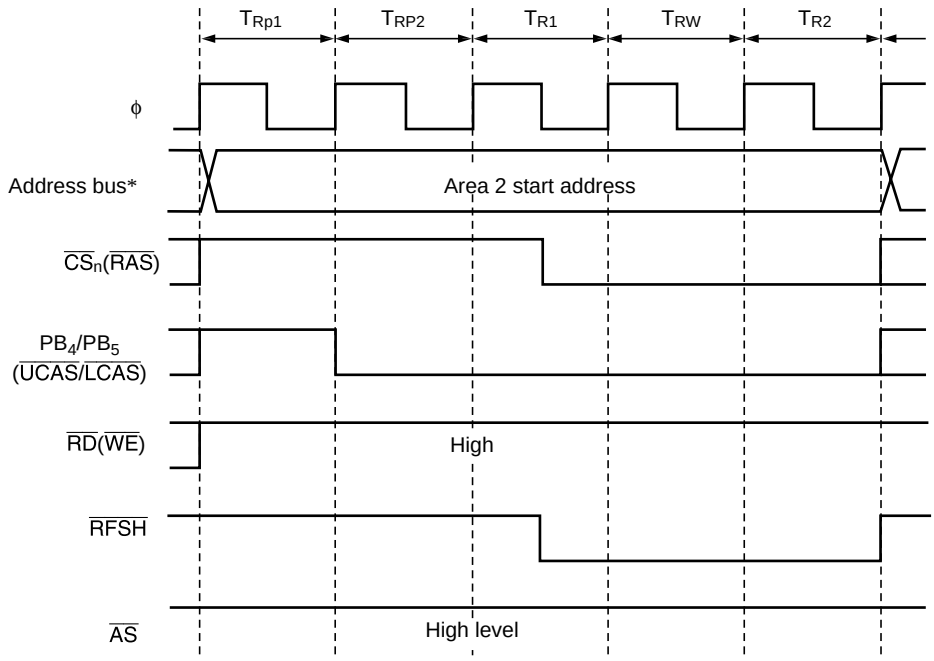
Figure 6.28 CBR Refresh Timing (CSEL = 0, TPC = 0, RLW = 0)

The basic CBS refresh cycle timing comprises three states: one RAS precharge cycle (T_{RP}) state, and two RAS output cycle (T_{R1}, T_{R2}) states. Either one or two states can be selected for the RAS precharge cycle. When the TPC bit is set to 1 in DRCRB, $\overline{RAS}$ signal output is delayed by one cycle. This does not affect the timing of $\overline{UCAS}$ and $\overline{LCAS}$ output.

Use the RLW bit in DRCRB to adjust the $\overline{RAS}$ signal width. A single refresh wait state (T_{RW}) can be inserted between the T_{R1} state and T_{R2} state by setting the RLW bit to 1.

The RLW bit setting is valid only for CBR refresh cycles, and does not affect DRAM read/write cycles. The number of states in the CBR refresh cycle is not affected by the settings in ASTCR, WCRH, or WCRL, or by the state of the $\overline{WAIT}$ pin.

Figure 6.29 shows the timing when the TPC bit and RLW bit are both set to 1.



Note: * In address update mode 1, the area 2 start address is output.
In address update mode 2, the address in the preceding bus cycle is retained.

Figure 6.29 CBR Refresh Timing (CSEL = 0, TPC = 1, RLW = 1)

DRAM must be refreshed immediately after powering on in order to stabilize its internal state. When using the H8/3069R CAS-before-RAS refresh function, therefore, a DRAM stabilization period should be provided by means of interrupts by another timer module, or by counting the number of times bit 7 (CMF) of RTMCSR is set, for instance, immediately after bits DRAS2 to DRAS0 have been set in DRCRA.

Self-Refreshing: A self-refresh mode (battery backup mode) is provided for DRAM as a kind of standby mode. In this mode, refresh timing and refresh addresses are generated within the DRAM. The H8/3069R has a function that places the DRAM in self-refresh mode when the chip enters software standby mode.

To use the self-refresh function, set the SRFMD bit to 1 in DRCRA. When a SLEEP instruction is subsequently executed in order to enter software standby mode, the $\overline{CAS}$ and $\overline{RAS}$ signals are output and the DRAM enters self-refresh mode, as shown in figure 6.30.

When the chip exits software standby mode, $\overline{CAS}$ and $\overline{RAS}$ outputs go high.

The following conditions must be observed when the self-refresh function is used:

- When burst access is selected, RAS up mode must be selected before executing a SLEEP instruction in order to enter software standby mode. Therefore, if RAS down mode has been selected, the RDM bit in DRCRA must be cleared to 0 and RAS up mode selected before executing the SLEEP instruction. Select RAS down mode again after exiting software standby mode.
- The instruction immediately following a SLEEP instruction must not be located in an area designated as DRAM space.

The self-refresh function will not work properly unless the above conditions are observed.

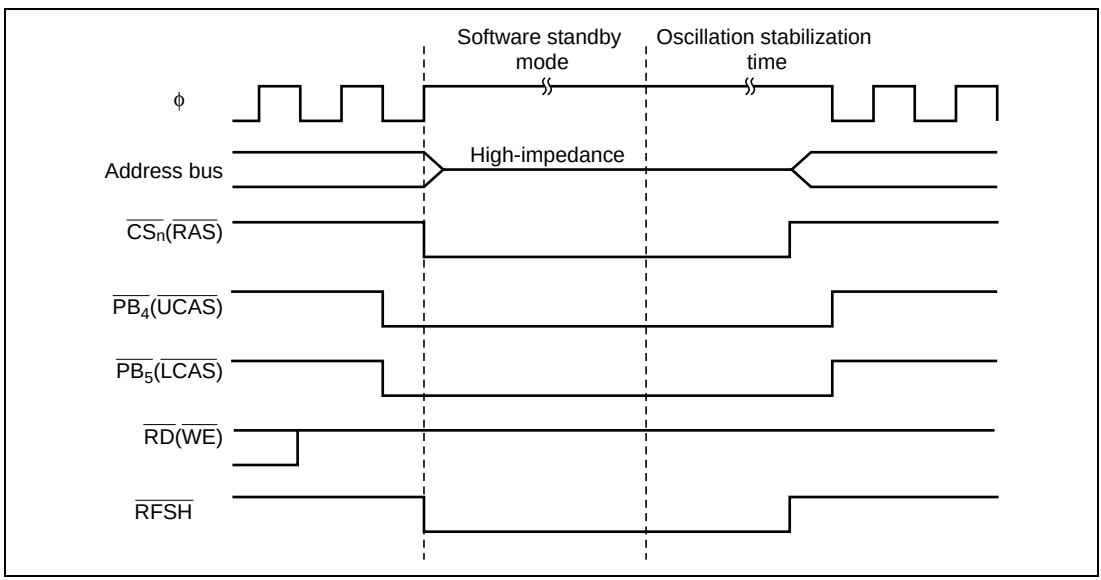


Figure 6.30 Self-Refresh Timing (CSEL = 0)

Refresh Signal ($\overline{RFSH}$): A refresh signal ($\overline{RFSH}$) that transmits a refresh cycle off-chip can be output by setting the RFSHE bit to 1 in DRCRA. $\overline{RFSH}$ output timing is shown in figures 6.28, 6.29, and 6.30.

6.5.12 Examples of Use

Examples of DRAM connection and program setup procedures are shown below. When the DRAM interface is used, check the DRAM device characteristics and choose the most appropriate method of use for that device.

Connection Examples

- Figure 6.31 shows typical interconnections when using two 2-CAS type 16-Mbit DRAMs using a × 16-bit organization, and the corresponding address map. The DRAMs used in this example are of the 10-bit row address × 10-bit column address type. Up to four DRAMs can be connected by designating areas 2 to 5 as DRAM space.

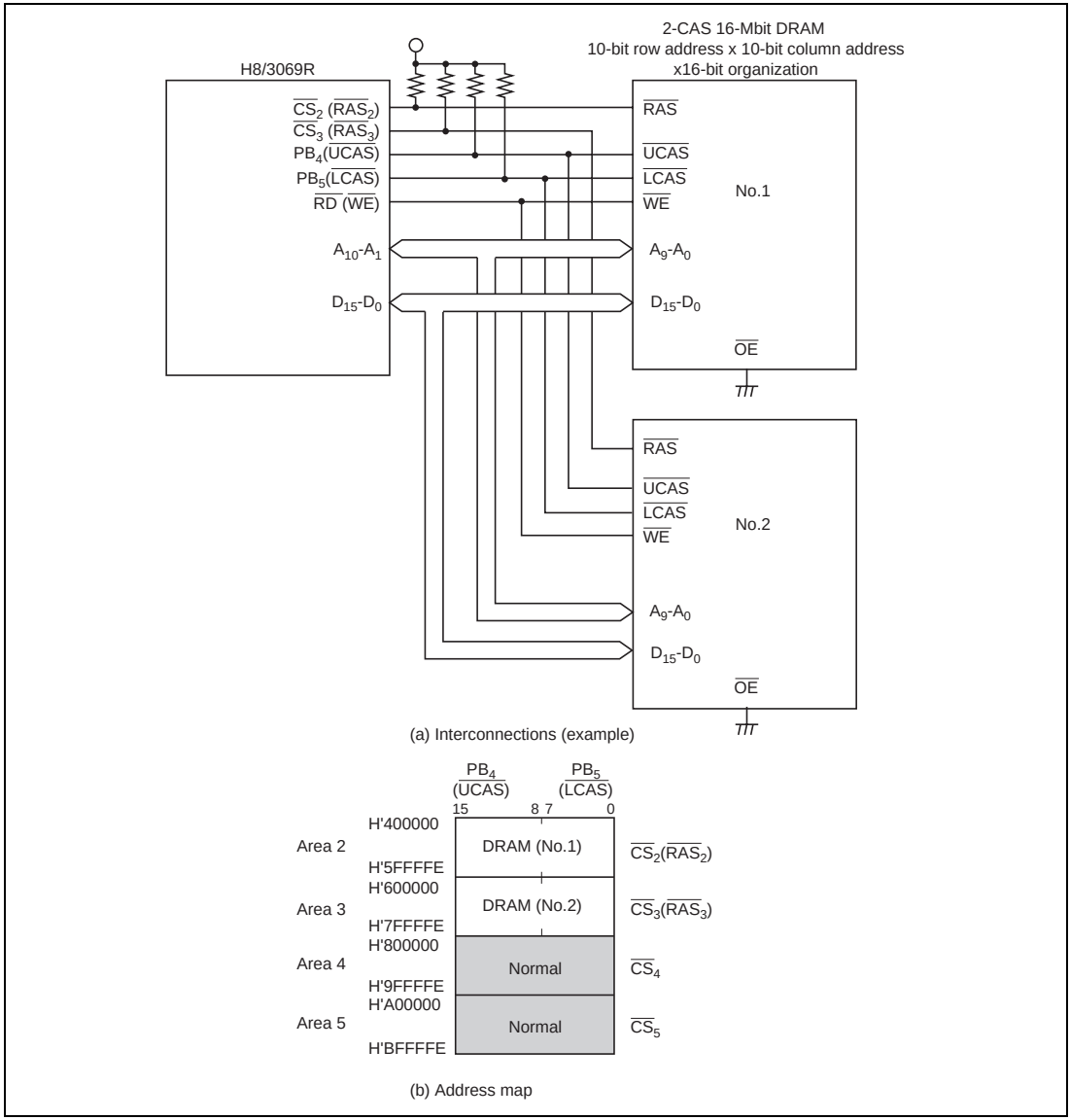


Figure 6.31 Interconnections and Address Map for 2-CAS 16-Mbit DRAMs with × 16-Bit Organization

- Figure 6.32 shows typical interconnections when using two 16-Mbit DRAMs using a × 8-bit organization, and the corresponding address map. The DRAMs used in this example are of the 11-bit row address × 10-bit column address type. The $\overline{CS}_2$ pin is used as the common $\overline{RAS}$ output pin for areas 2 and 3. When the $\overline{DRAM}$ address space spans a number of contiguous areas, as in this example, the appropriate setting of bits DRAS2 to DRAS0 enables a single $\overline{CS}$ pin to be used as the common $\overline{RAS}$ output pin for a number of areas, and makes it possible to directly connect large-capacity DRAM with address space that spans a maximum of four areas. Any unused $\overline{CS}$ pins (in this example, the $\overline{CS}_3$ pin) can be used as input/output ports.

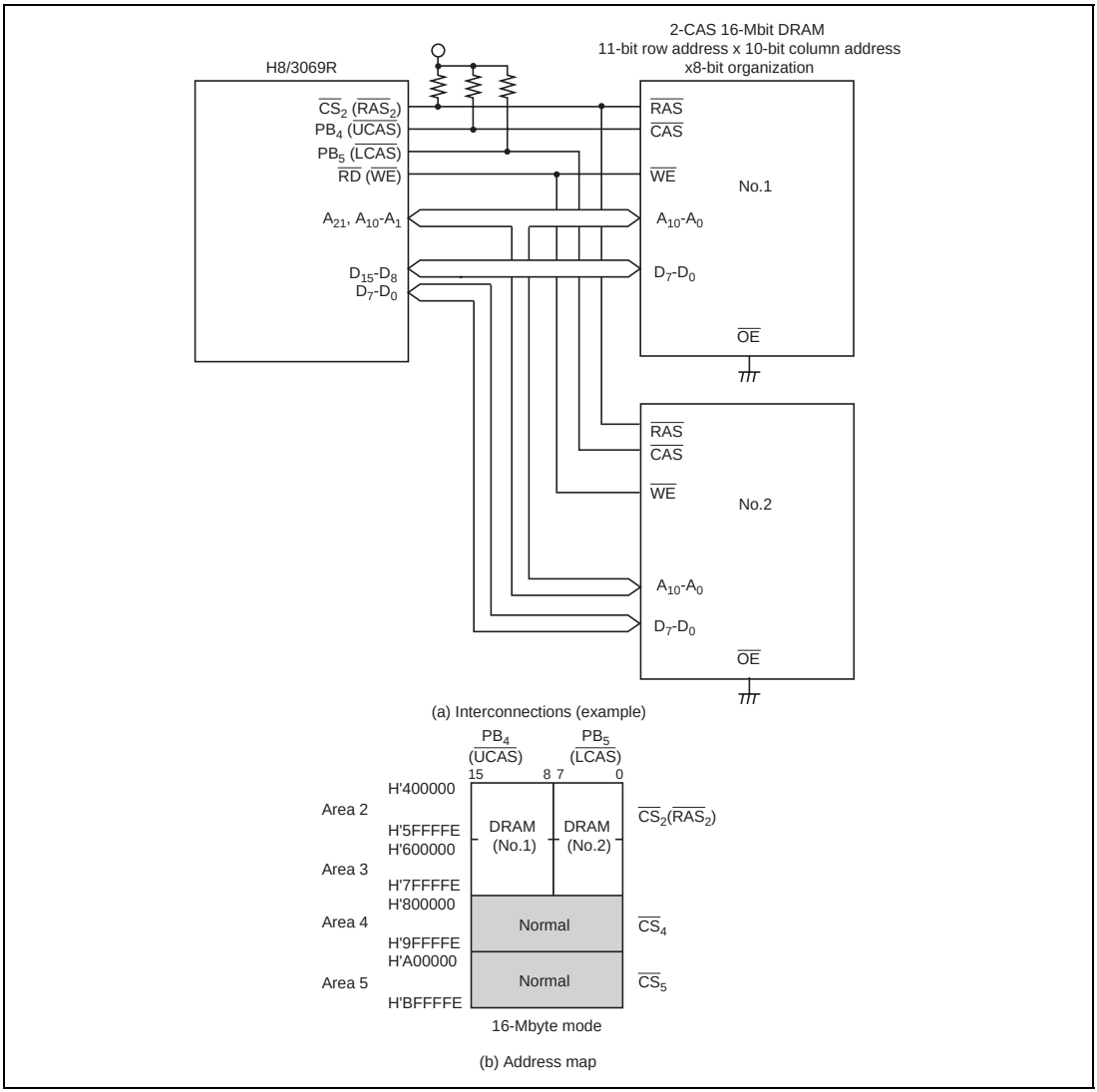


Figure 6.32 Interconnections and Address Map for 16-Mbit DRAMs with × 8-Bit Organization

- Figure 6.33 shows typical interconnections when using two 4-Mbit DRAMs, and the corresponding address map. The DRAMs used in this example are of the 9-bit row address × 9-bit column address type. In this example, upper address decoding allows multiple DRAMs to be connected to a single area. The $\overline{\text{RFSH}}$ pin is used in this case, since both DRAMs must be refreshed simultaneously. However, note that RAS down mode cannot be used in this interconnection example.

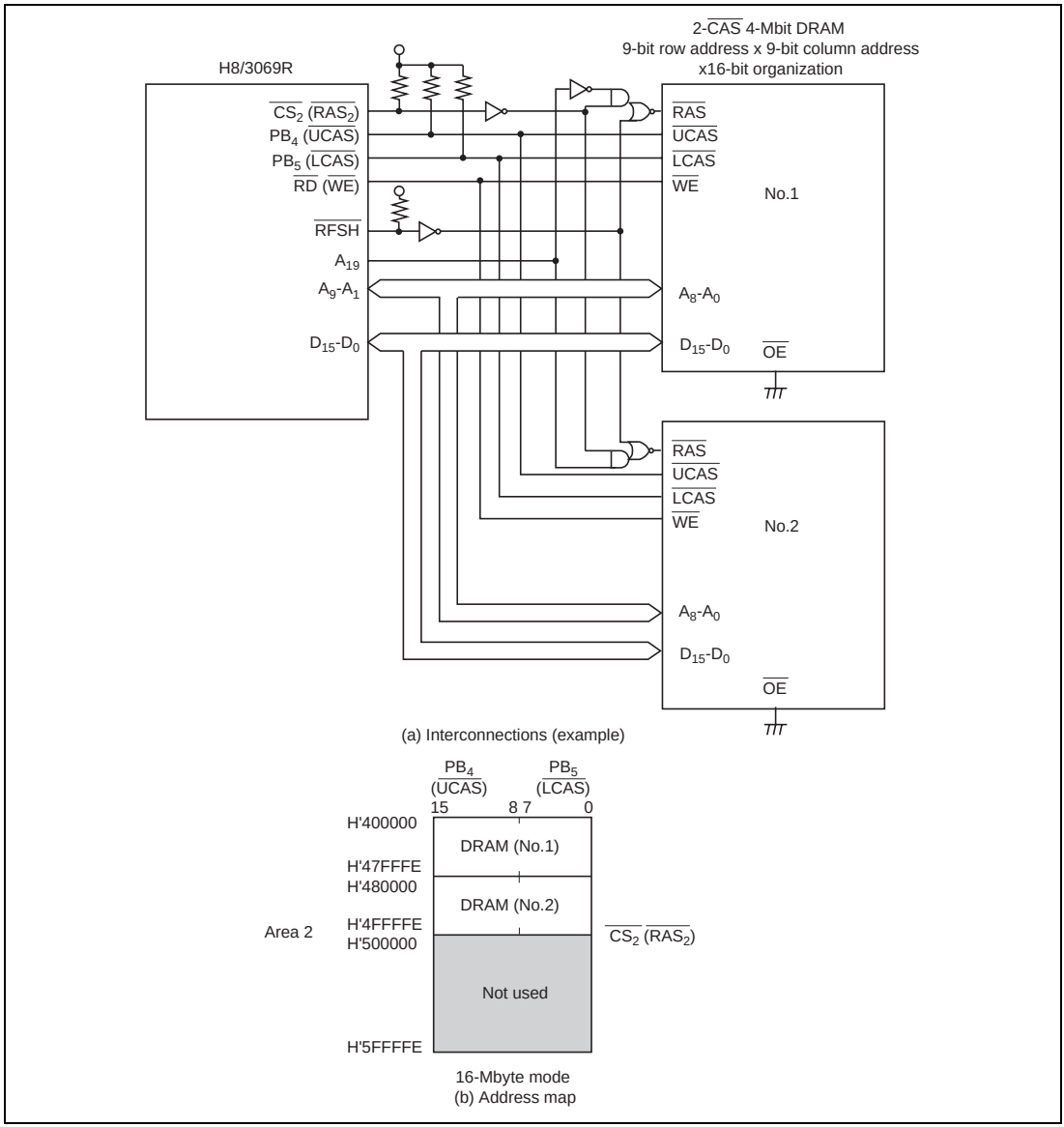


Figure 6.33 Interconnections and Address Map for 2-CAS 4-Mbit DRAMs with × 16-Bit Organization

Example of Program Setup Procedure: Figure 6.34 shows an example of the program setup procedure.

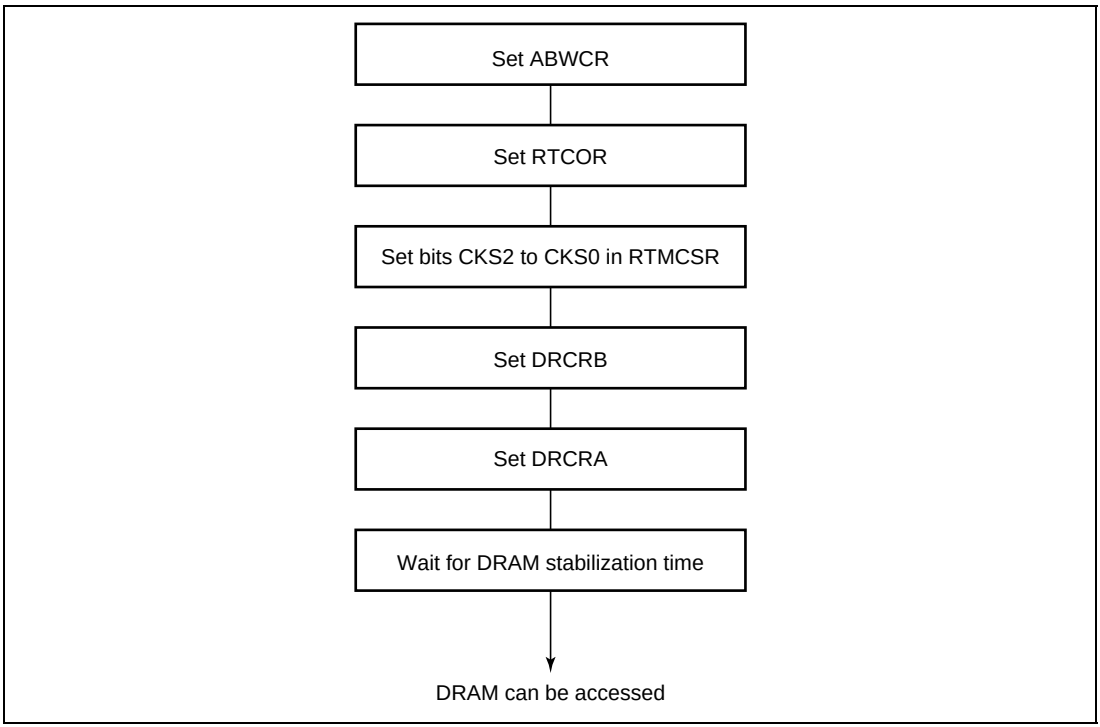


Figure 6.34 Example of Setup Procedure when Using DRAM Interface

6.5.13 Usage Notes

Note the following points when using the DRAM refresh function.

- Refresh cycles will not be executed when the external bus released state, software standby mode, or a bus cycle is extended by means of wait state insertion. Refreshing must therefore be performed by other means in these cases.
- If a refresh request is generated internally while the external bus is released, the first request is retained and a single refresh cycle will be executed after the bus-released state is cleared. Figure 6.35 shows the bus cycle in this case.
- When a bus cycle is extended by means of wait state insertion, the first request is retained in the same way as when the external bus has been released.
- In the event of contention with a bus request from an external bus master when a transition is made to software standby mode, the $\overline{\text{BACK}}$ and strobe states may be indeterminate after the transition to software standby mode (see figure 6.36).

When software standby mode is used, the BRLE bit should be cleared to 0 in BRCR before executing the SLEEP instruction.

Similar contention in a transition to self-refresh mode may prevent dependable strobe waveform output. This can also be avoided by clearing the BRLE bit to 0 in BRCR.

- Immediately after self-refreshing is cleared, external bus release is possible during a given period until the start of a CPU cycle. Attention must be paid to the $\overline{\text{RAS}}$ state to ensure that the specification for the $\overline{\text{RAS}}$ precharge time immediately after self-refreshing is met.

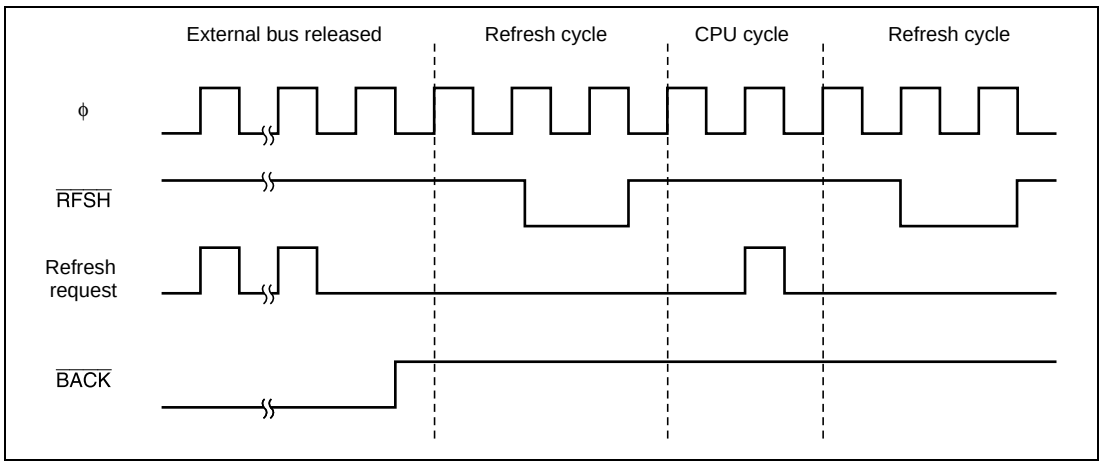


Figure 6.35 Bus-Released State and Refresh Cycles

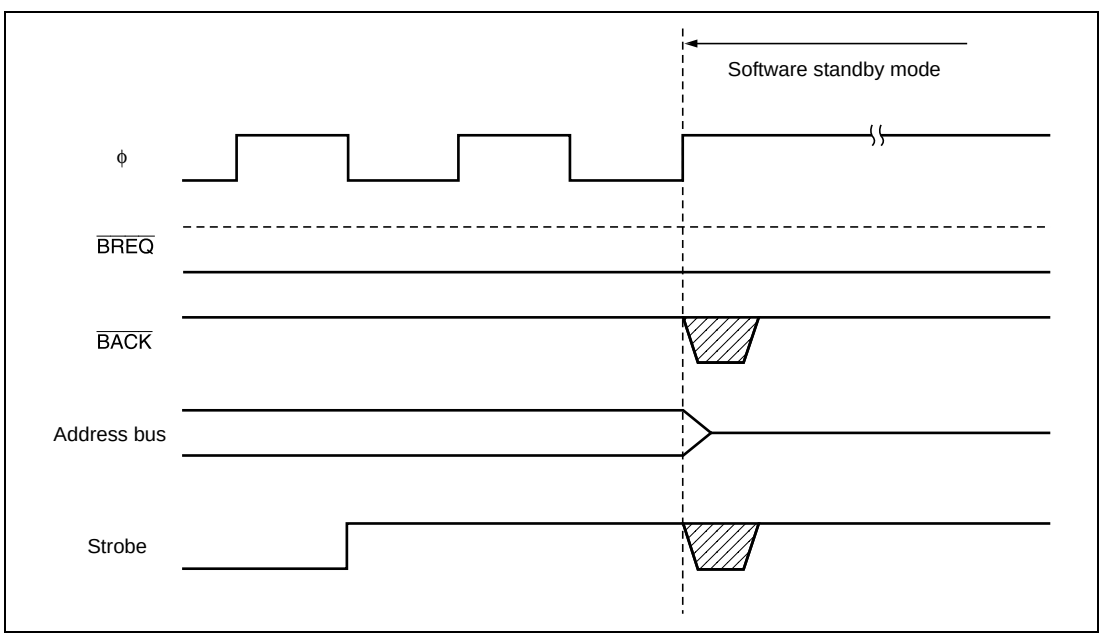


Figure 6.36 Bus-Released State and Software Standby Mode

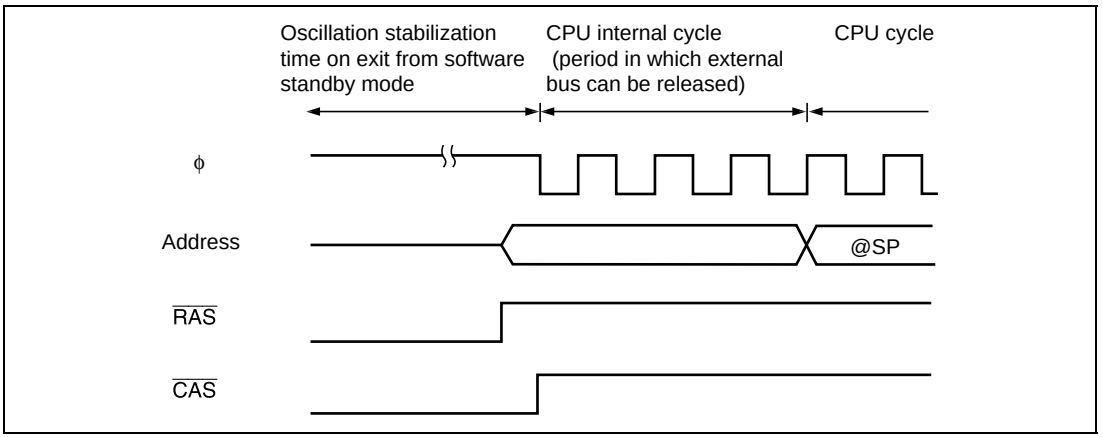


Figure 6.37 Self-Refresh Clearing

6.6 Interval Timer

6.6.1 Operation

When DRAM is not connected to the H8/3069R chip, the refresh timer can be used as an interval timer by clearing bits DRAS2 to DRAS0 in DRCRA to 0. After setting RTCOR, selection a clock source with bits CKS2 to CKS0 in RTMCSR, and set the CMIE bit to 1.

Timing of Setting of Compare Match Flag and Clearing by Compare Match: The CMF flag in RTMCSR is set to 1 by a compare match output when the RTCOR and RTCNT values match. The compare match signal is generated in the last state in which the values match (when RTCNT is updated from the matching value to a new value). Accordingly, when RTCNT and RTCOR match, the compare match signal is not generated until the next counter clock pulse. Figure 6.38 shows the timing.

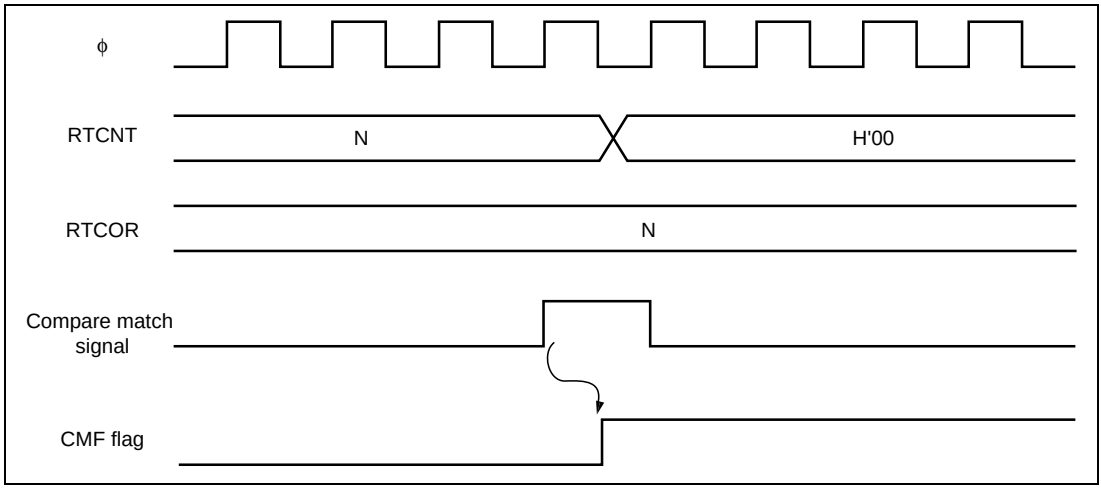


Figure 6.38 Timing of CMF Flag Setting

Operation in Power-Down State: The interval timer operates in sleep mode. It does not operate in hardware standby mode. In software standby mode, RTCNT and RTMCSR bits 7 and 6 are initialized, but RTMCSR bits 5 to 3 and RTCOR retain their settings prior to the transition to software standby mode.

Contention between RTCNT Write and Counter Clear: If a counter clear signal occurs in the T_3 state of an RTCNT write cycle, clearing of the counter takes priority and the write is not performed. See figure 6.39.

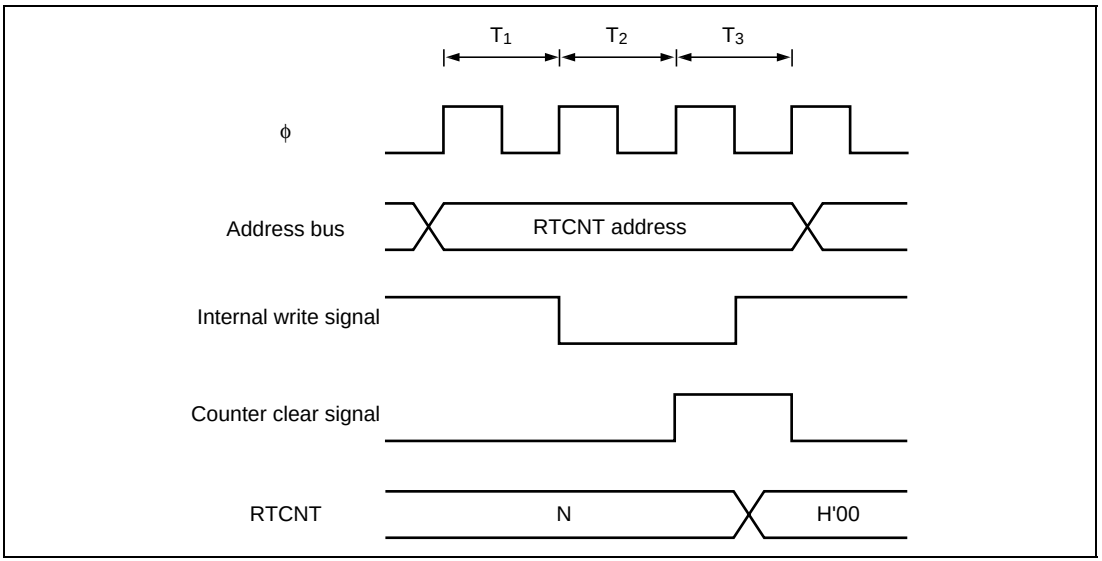


Figure 6.39 Contention between RTCNT Write and Clear

Contention between RTCNT Write and Increment: If an increment pulse occurs in the T_3 state of an RTCNT write cycle, writing takes priority and RTCNT is not incremented. See figure 6.40.

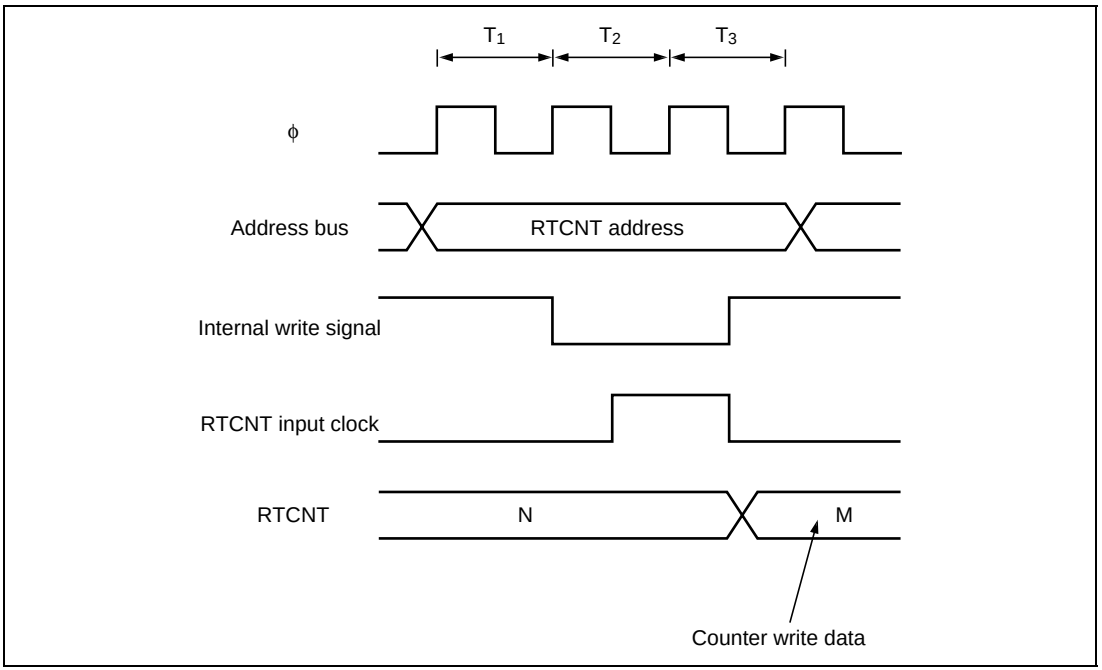


Figure 6.40 Contention between RTCNT Write and Increment

Contention between RTCOR Write and Compare Match: If a compare match occurs in the T_3 state of an RTCOR write cycle, writing takes priority and the compare match signal is inhibited. See figure 6.41.

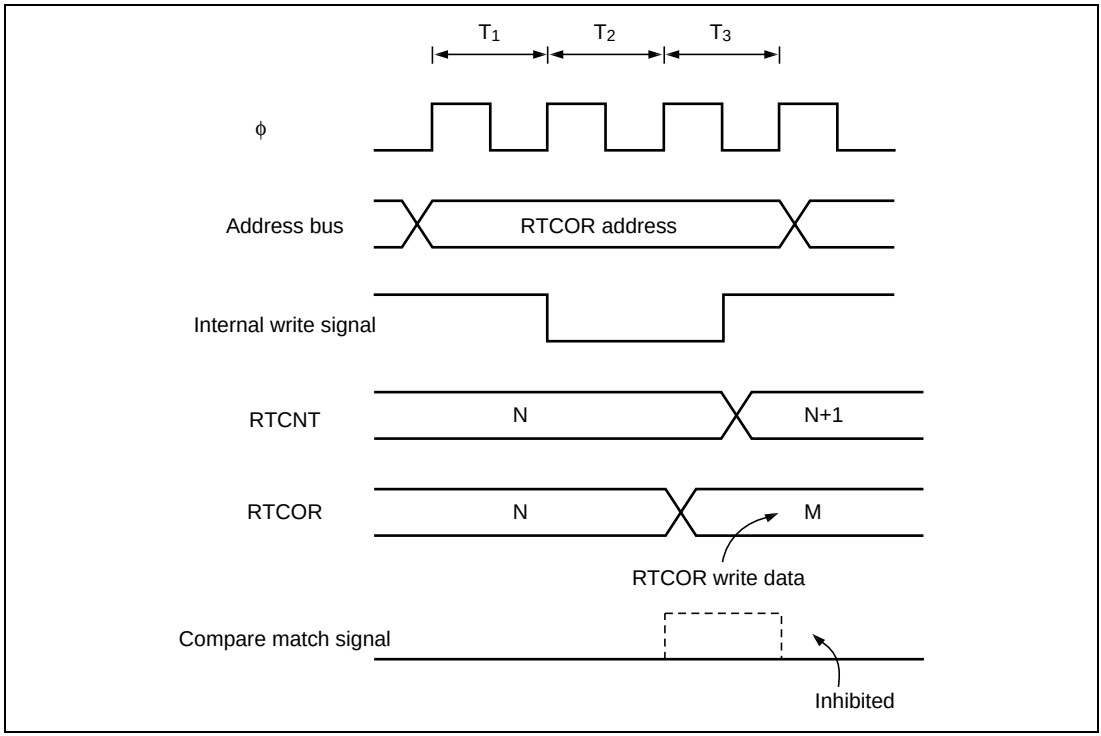
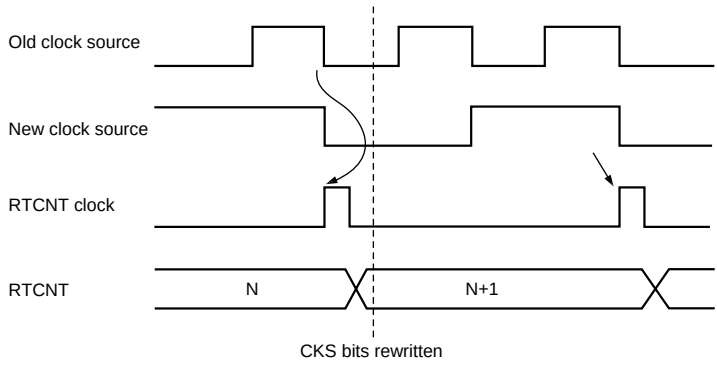
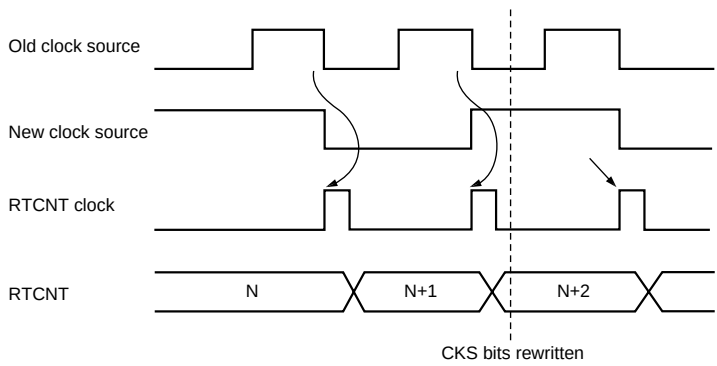


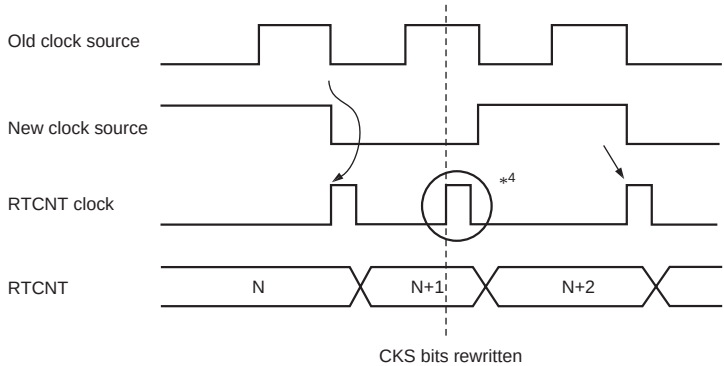
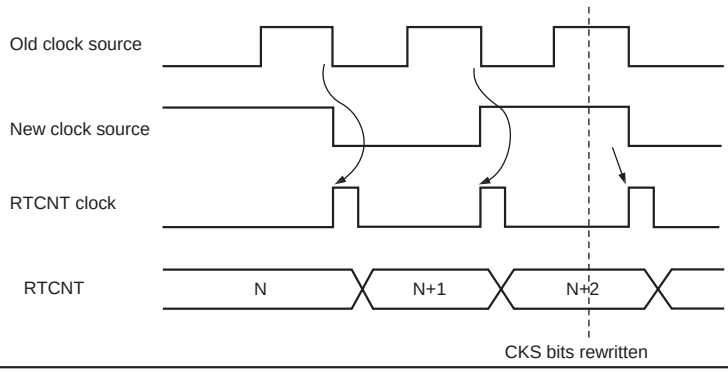
Figure 6.41 Contention between RTCOR Write and Compare Match

RTCNT Operation at Internal Clock Source Switchover: Switching internal clock sources may cause RTCNT to increment, depending on the switchover timing. Table 6.10 shows the relation between the time of the switchover (by writing to bits CKS2 to CKS0) and the operation of RTCNT.

The RTCNT input clock is generated from the internal clock source by detecting the falling edge of the internal clock. If a switchover is made from a high clock source to a low clock source, as in case No. 3 in table 6.10, the switchover will be regarded as a falling edge, an RTCNT clock pulse will be generated, and RTCNT will be incremented.

Table 6.10 Internal Clock Switchover and RTCNT Operation

No.	CKS2 to CKS0 Write Timing	RTCNT Operation
1	Low → Low switchover*1	
2	Low → High switchover*2	

No.	CKS2 to CKS0 Write Timing	RTCNT Operation
3	High → Low switchover*3	
4	High → High switchover*4	

Notes: 1. Including switchovers from a low clock source to the halted state, and from the halted state to a low clock source.
2. Including switchover from the halted state to a high clock source.
3. Including switchover from a high clock source to the halted state.
4. The switchover is regarded as a falling edge, causing RTCNT to increment.

6.7 Interrupt Sources

Compare match interrupts (CMI) can be generated when the refresh timer is used as an interval timer. Compare match interrupt requests are masked/unmasked with the CMIE bit in RTMCSR.

6.8 Burst ROM Interface

6.8.1 Overview

With the H8/3069R, external space area 0 can be designated as burst ROM space, and burst ROM space interfacing can be performed. The burst ROM space interface enables 16-bit organization ROM with burst access capability to be accessed at high speed. Area 0 is designated as burst ROM space by means of the BROME bit in BCR.

Continuous burst access of a maximum or four or eight words can be performed on external space area 0. Two or three states can be selected for burst access.

6.8.2 Basic Timing

The number of states in the initial cycle (full access) and a burst cycle of the burst ROM interface is determined by the setting of the AST0 bit in ASTCR. When the AST0 bit is set to 1, wait states can also be inserted in the initial cycle. Wait states cannot be inserted in a burst cycle.

Burst access of up to four words is performed when the BRSTS0 bit is cleared to 0 in BCR, and burst access of up to eight words when the BRSTS0 bit is set to 1. The number of burst access states is two when the BRSTS1 bit is cleared to 0, and three when the BRSTS1 bit is set to 1.

The basic access timing for burst ROM space is shown in figure 6.42.

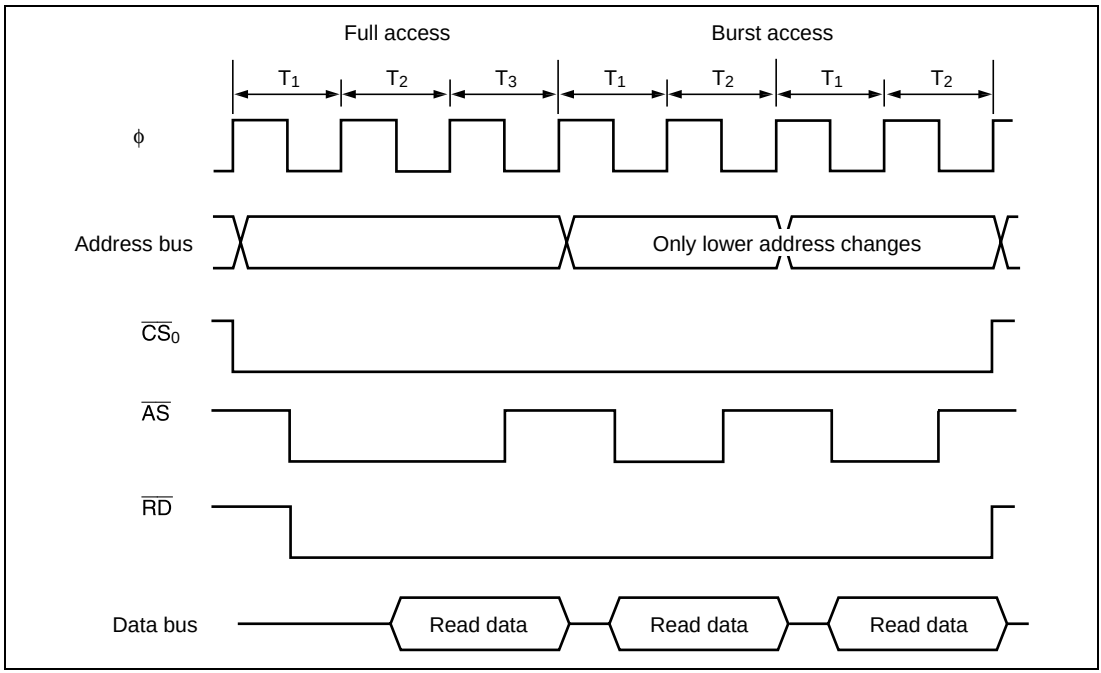


Figure 6.42 Example of Burst ROM Access Timing

6.8.3 Wait Control

As with the basic bus interface, either program wait insertion or pin wait insertion using the $\overline{\text{WAIT}}$ pin can be used in the initial cycle (full access) of the burst ROM interface.

Wait states cannot be inserted in a burst cycle.

6.9 Idle Cycle

6.9.1 Operation

When the H8/3069R chip accesses external space, it can insert a 1-state idle cycle (T_I) between bus cycles in the following cases: (1) when read accesses between different areas occur consecutively, (2) when a write cycle occurs immediately after a read cycle, and (3) immediately after a DRAM space access. By inserting an idle cycle it is possible, for example, to avoid data collisions between ROM, which has a long output floating time, and high-speed memory, I/O interfaces, and so on.

The ICIS1 and ICIS0 bits in BCR both have an initial value of 1, so that an idle cycle is inserted in the initial state. If there are no data collisions, the ICIS bits can be cleared.

Consecutive Reads between Different Areas: If consecutive reads between different areas occur while the ICIS1 bit is set to 1 in BCR, an idle cycle is inserted at the start of the second read cycle.

Figure 6.43 shows an example of the operation in this case. In this example, bus cycle A is a read cycle from ROM with a long output floating time, and bus cycle B is a read cycle from SRAM, each being located in a different area. In (a), an idle cycle is not inserted, and a collision occurs in cycle B between the read data from ROM and that from SRAM. In (b), an idle cycle is inserted, and a data collision is prevented.

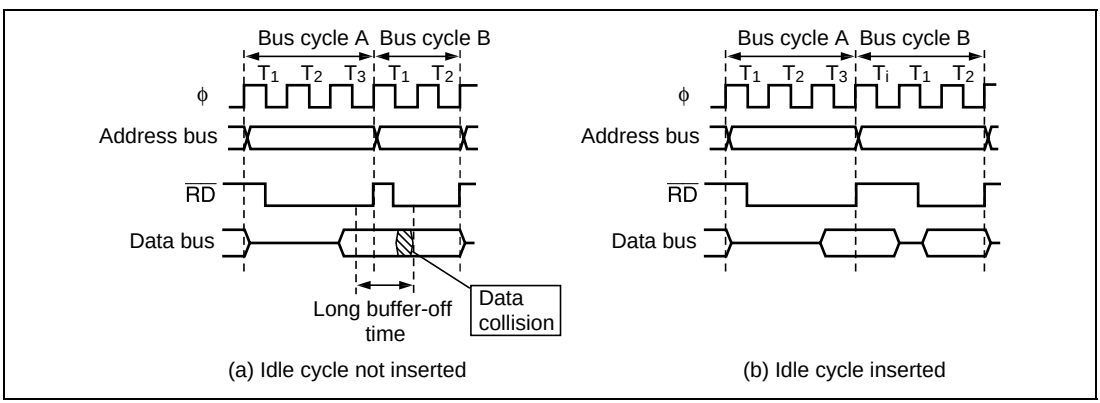


Figure 6.43 Example of Idle Cycle Operation (1) (ICIS1 = 1)

Write after Read: If an external write occurs after an external read while the ICIS0 bit is set to 1 in BCR, an idle cycle is inserted at the start of the write cycle.

Figure 6.44 shows an example of the operation in this case. In this example, bus cycle A is a read cycle from ROM with a long output floating time, and bus cycle B is a CPU write cycle.

In (a), an idle cycle is not inserted, and a collision occurs in cycle B between the read data from ROM and the CPU write data. In (b), an idle cycle is inserted, and a data collision is prevented.

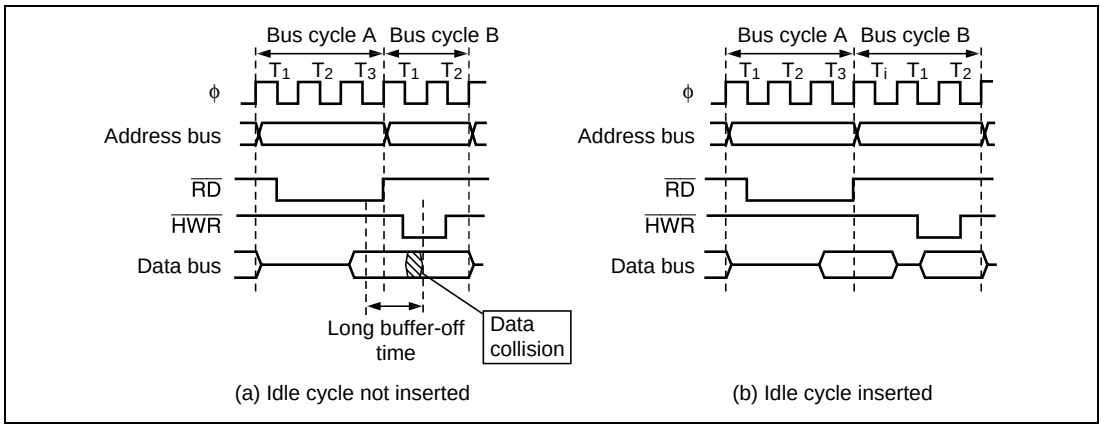


Figure 6.44 Example of Idle Cycle Operation (2) (ICIS0 = 1)

External Address Space Access Immediately after DRAM Space Access: If a DRAM space access is followed by a non-DRAM external access when $\overline{\text{HWR}}$ and $\overline{\text{LWR}}$ have been selected as the $\overline{\text{UCAS}}$ and $\overline{\text{LCAS}}$ output pins by means of the CSEL bit in DRCRB, a T_i cycle is inserted regardless of the settings of bits ICIS0 and ICIS1 in BCR. Figure 6.45 shows an example of the operation.

This is done to prevent simultaneous changing of the $\overline{\text{HWR}}$ and $\overline{\text{LWR}}$ signals used as $\overline{\text{UCAS}}$ and $\overline{\text{LCAS}}$ in DRAM space and $\overline{\text{CSn}}$ for the space in the next cycle, and so avoid an erroneous write to the external device in the next cycle.

A T_i cycle is not inserted when PB_4 and PB_5 have been selected as the $\overline{\text{UCAS}}$ and $\overline{\text{LCAS}}$ output pins.

In the case of consecutive DRAM space access precharge cycles (T_p), the ICIS0 bit settings are invalid. In the case of consecutive reads between different areas, for example, if the second access is a DRAM access, only a T_p cycle is inserted, and a T_i cycle is not. The timing in this case is shown in figure 6.46.

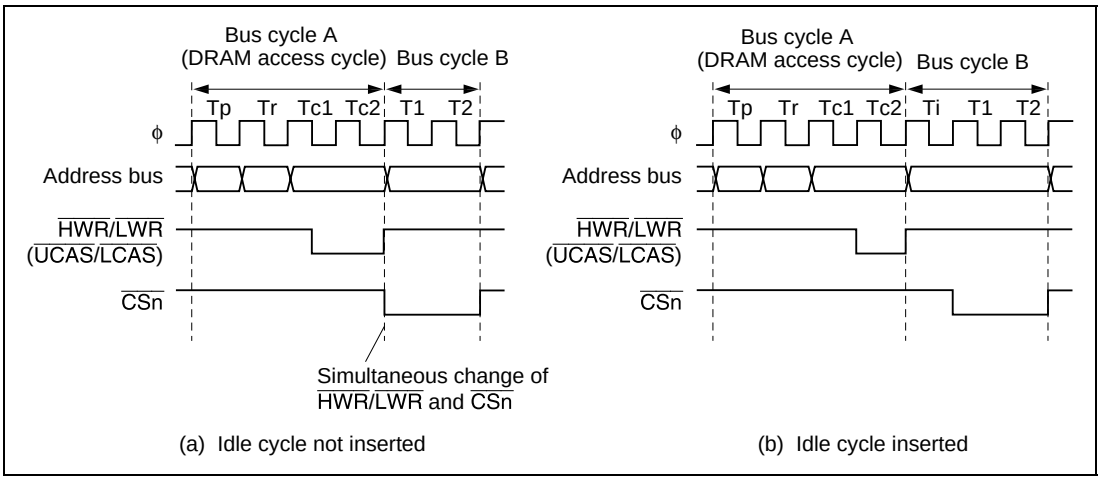


Figure 6.45 Example of Idle Cycle Operation (3) ($\overline{\text{HWR}}$/$\overline{\text{LWR}}$ Used as $\overline{\text{UCAS}}$/$\overline{\text{LCAS}}$)

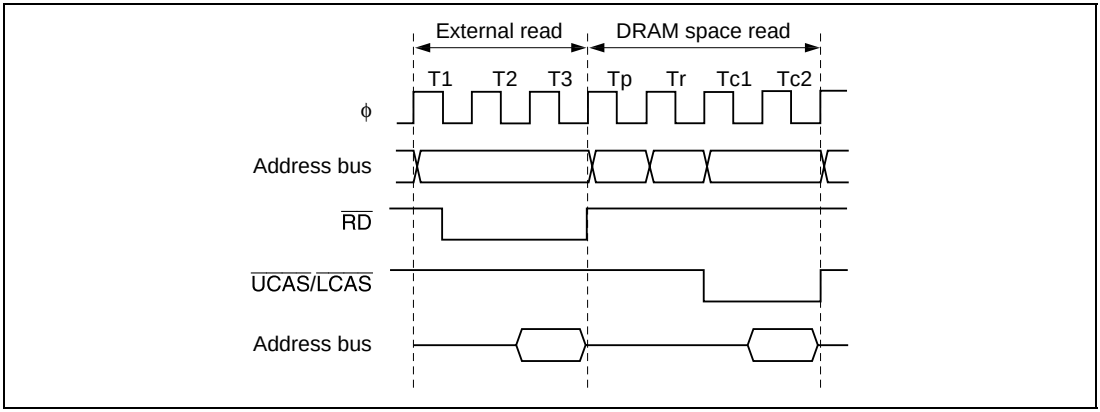


Figure 6.46 Example of Idle Cycle Operation (4) (Consecutive Precharge Cycles)

Usage Notes: When non-insertion of idle cycles is set, the rise (negation) of $\overline{\text{RD}}$ and the fall (assertion) of $\overline{\text{CSn}}$ may occur simultaneously. An example of the operation is shown in figure 6.47.

If consecutive reads between different external areas occur while the ICIS1 bit is cleared to 0 in BCR, or if a write cycle to a different external area occurs after an external read while the ICIS0 bit is cleared to 0, the $\overline{\text{RD}}$ negation in the first read cycle and the $\overline{\text{CSn}}$ assertion in the following bus cycle will occur simultaneously. Therefore, depending on the output delay time of each signal, it is possible that the low-level output of $\overline{\text{RD}}$ in the preceding read cycle and the low-level output of $\overline{\text{CSn}}$ in the following bus cycle will overlap.

A setting whereby idle cycle insertion is not performed can be made only when $\overline{\text{RD}}$ and $\overline{\text{CSn}}$ do not change simultaneously, or when it does not matter if they do.

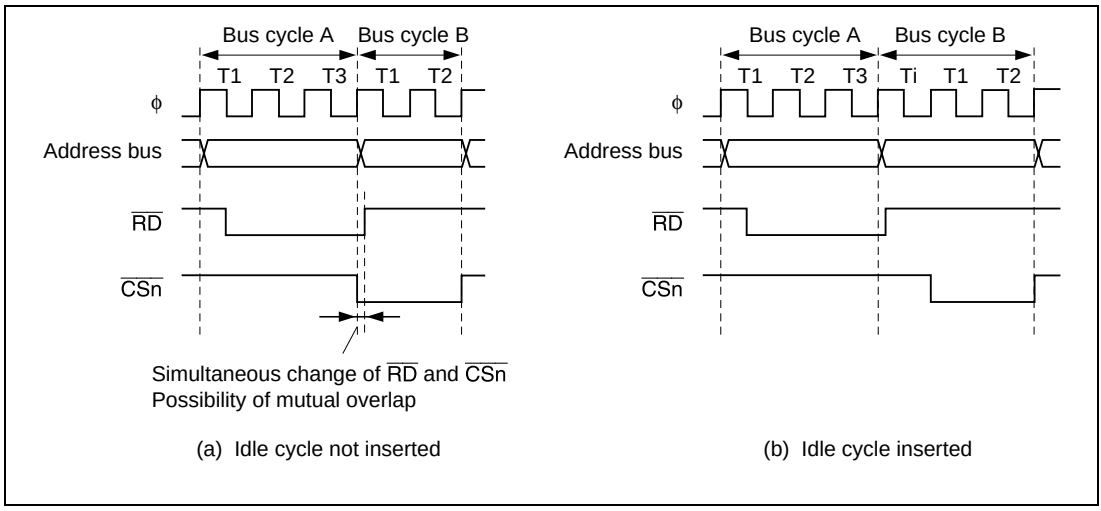


Figure 6.47 Example of Idle Cycle Operation (5)

6.9.2 Pin States in Idle Cycle

Table 6.11 shows the pin states in an idle cycle.

Table 6.11 Pin States in Idle Cycle

Pins	Pin State
A_{23} to A_0	Next cycle address value
D_{15} to D_0	High impedance
$\overline{CSn}$	High*
$\overline{UCAS}$, $\overline{LCAS}$	High
$\overline{AS}$	High
$\overline{RD}$	High
$\overline{HWR}$	High
$\overline{LWR}$	High

Note: * Remains low in DRAM space RAS down mode.

6.10 Bus Arbiter

The bus controller has a built-in bus arbiter that arbitrates between different bus masters. There are four bus masters: the CPU, DMA controller (DMAC), DRAM interface, and an external bus master. When a bus master has the bus right it can carry out read, write, or refresh access. Each bus master uses a bus request signal to request the bus right. At fixed times the bus arbiter determines priority and uses a bus acknowledge signal to grant the bus to a bus master, which can the operate using the bus.

The bus arbiter checks whether the bus request signal from a bus master is active or inactive, and returns an acknowledge signal to the bus master. When two or more bus masters request the bus, the highest-priority bus master receives an acknowledge signal. The bus master that receives an acknowledge signal can continue to use the bus until the acknowledge signal is deactivated.

The bus master priority order is:

(High) External bus master > DRAM interface > DMAC > CPU (Low)

The bus arbiter samples the bus request signals and determines priority at all times, but it does not always grant the bus immediately, even when it receives a bus request from a bus master with higher priority than the current bus master. Each bus master has certain times at which it can release the bus to a higher-priority bus master.

6.10.1 Operation

CPU: The CPU is the lowest-priority bus master. If the DMAC, DRAM interface, or an external bus master requests the bus while the CPU has the bus right, the bus arbiter transfers the bus right to the bus master that requested it. The bus right is transferred at the following times:

- The bus right is transferred at the boundary of a bus cycle. If word data is accessed by two consecutive byte accesses, however, the bus right is not transferred between the two byte accesses.
- If another bus master requests the bus while the CPU is performing internal operations, such as executing a multiply or divide instruction, the bus right is transferred immediately. The CPU continues its internal operations.
- If another bus master requests the bus while the CPU is in sleep mode, the bus right is transferred immediately.

DMAC: When the DMAC receives an activation request, it requests the bus right from the bus arbiter. If the DMAC is bus master and the DRAM interface or an external bus master requests the bus, the bus arbiter transfers the bus right from the DMAC to the bus master that requested the bus. The bus right is transferred at the following times.

The bus right is transferred when the DMAC finishes transferring one byte or one word. A DMAC transfer cycle consists of a read cycle and a write cycle. The bus right is not transferred between the read cycle and the write cycle.

There is a priority order among the DMAC channels. For details see section 7.4.9, Multiple-Channel Operation.

DRAM Interface: The DRAM interface requests the bus right from the bus arbiter when a refresh cycle request is issued, and releases the bus at the end of the refresh cycle. For details see section 6.5, DRAM Interface.

External Bus Master: When the BRLE bit is set to 1 in BRCR, the bus can be released to an external bus master. The external bus master has highest priority, and requests the bus right from the bus arbiter driving the $\overline{\text{BREQ}}$ signal low. Once the external bus master acquires the bus, it keeps the bus until the $\overline{\text{BREQ}}$ signal goes high. While the bus is released to an external bus master, the H8/3069R chip holds the address bus, data bus, bus control signals ($\overline{\text{AS}}$, $\overline{\text{RD}}$, $\overline{\text{HWR}}$, and $\overline{\text{LWR}}$), and chip select signals ($\overline{\text{CS}}$n: n = 7 to 0) in the high-impedance state, and holds the $\overline{\text{BACK}}$ pin in the low output state.

The bus arbiter samples the $\overline{\text{BREQ}}$ pin at the rise of the system clock (ϕ). If $\overline{\text{BREQ}}$ is low, the bus is released to the external bus master at the appropriate opportunity. The $\overline{\text{BREQ}}$ signal should be held low until the $\overline{\text{BACK}}$ signal goes low.

When the $\overline{\text{BREQ}}$ pin is high in two consecutive samples, the $\overline{\text{BACK}}$ pin is driven high to end the bus-release cycle.

Figure 6.48 shows the timing when the bus right is requested by an external bus master during a read cycle in a two-state access area. There is a minimum interval of three states from when the $\overline{\text{BREQ}}$ signal goes low until the bus is released.

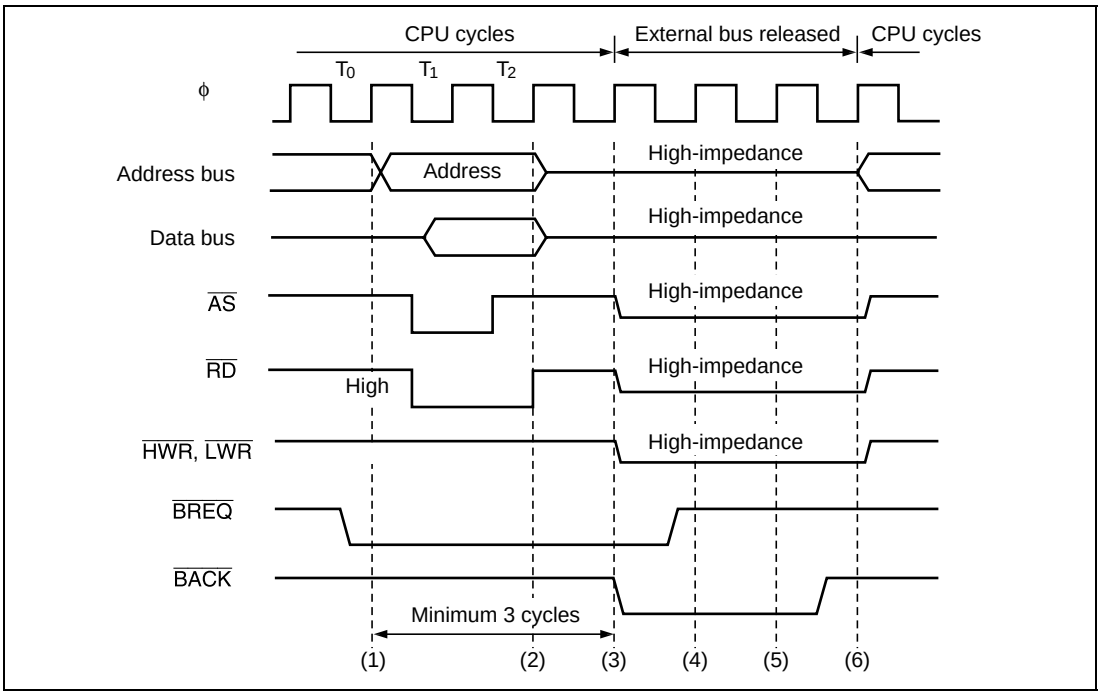


Figure 6.48 Example of External Bus Master Operation

In the event of contention with a bus request from an external bus master when a transition is made to software standby mode, the $\overline{\text{BACK}}$ and strobe states may be indeterminate after the transition to software standby mode (see figure 6.36).

When software standby mode is used, the BRLE bit should be cleared to 0 in BRCR before executing the SLEEP instruction.

6.11 Register and Pin Input Timing

6.11.1 Register Write Timing

ABWCR, ASTCR, WCRH, and WCRL Write Timing: Data written to ABWCR, ASTCR, WCRH, and WCRL takes effect starting from the next bus cycle. Figure 6.49 shows the timing when an instruction fetched from area 0 changes area 0 from three-state access to two-state access.

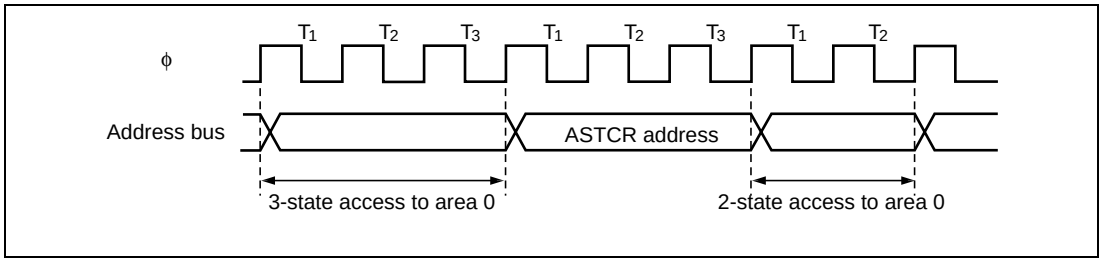


Figure 6.49 ASTCR Write Timing

DDR and CSCR Write Timing: Data written to DDR or CSCR for the port corresponding to the $\overline{CS}$n pin to switch between $\overline{CS}$n output and generic input takes effect starting from the T_3 state of the DDR write cycle. Figure 6.50 shows the timing when the $\overline{CS}_1$ pin is changed from generic input to $\overline{CS}_1$ output.

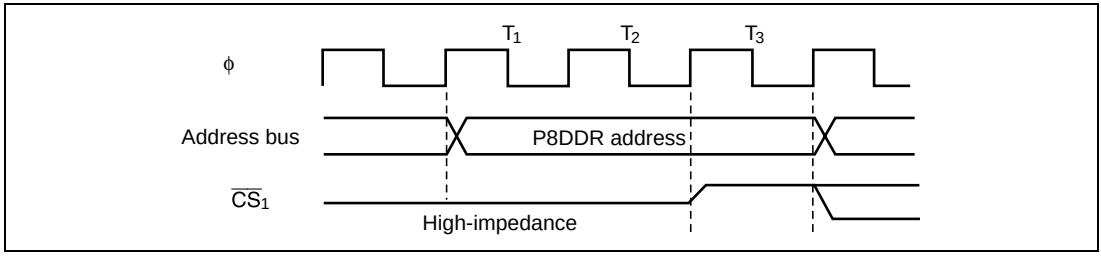


Figure 6.50 DDR Write Timing

BRCR Write Timing: Data written to BRCR to switch between A_{23}, A_{22}, A_{21}, or A_{20} output and generic input or output takes effect starting from the T_3 state of the BRCR write cycle. Figure 6.51 shows the timing when a pin is changed from generic input to A_{23}, A_{22}, A_{21}, or A_{20} output.

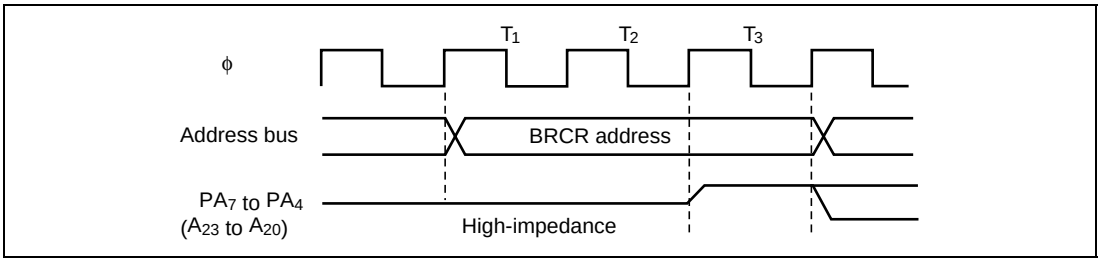


Figure 6.51 BRCR Write Timing

6.11.2 $\overline{\text{BREQ}}$ Pin Input Timing

After driving the $\overline{\text{BREQ}}$ pin low, hold it low until $\overline{\text{BACK}}$ goes low. If $\overline{\text{BREQ}}$ returns to the high level before $\overline{\text{BACK}}$ goes lows, the bus arbiter may operate incorrectly.

To terminate the external-bus-released state, hold the $\overline{\text{BREQ}}$ signal high for at least three states. If $\overline{\text{BREQ}}$ is high for too short an interval, the bus arbiter may operate incorrectly.

Section 7 DMA Controller

7.1 Overview

The H8/3069R has an on-chip DMA controller (DMAC) that can transfer data on up to four channels.

When the DMA controller is not used, it can be independently halted to conserve power. For details see section 20.6, Module Standby Function.

7.1.1 Features

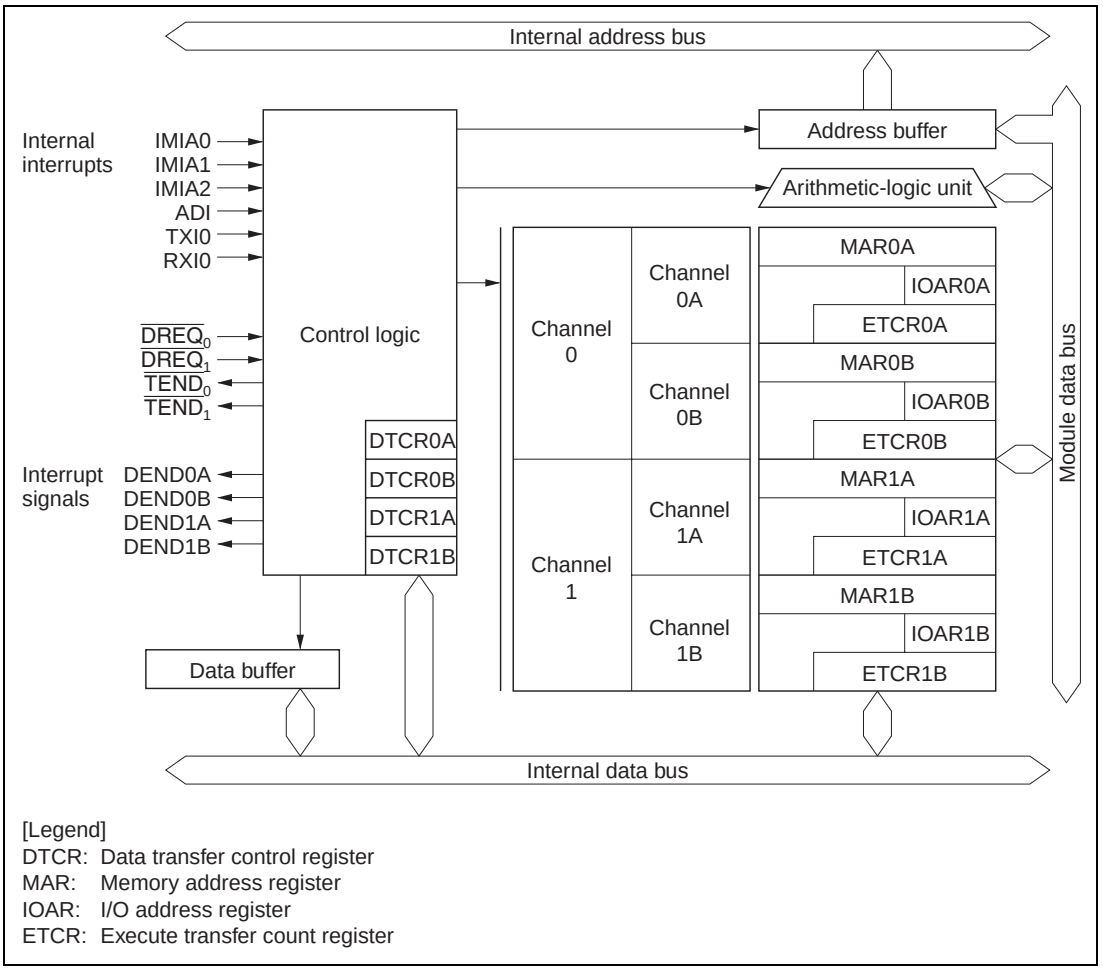
DMAC features are listed below.

- Selection of short address mode or full address mode
  Short address mode
  - 8-bit source address and 24-bit destination address, or vice versa
  - Maximum four channels available
  - Selection of I/O mode, idle mode, or repeat mode

  Full address mode
  - 24-bit source and destination addresses
  - Maximum two channels available
  - Selection of normal mode or block transfer mode
- Directly addressable 16-Mbyte address space
- Selection of byte or word transfer
- Activation by internal interrupts, external requests, or auto-request (depending on transfer mode)
  - 16-bit timer compare match/input capture interrupts (×3)
  - Serial communication interface (SCI channel 0) transmit-data-empty/receive-data-full interrupts
  - External requests
  - Auto-request
  - A/D converter conversion-end interrupt

7.1.2 Block Diagram

Figure 7.1 shows a DMAC block diagram.



[Legend]
DTCR: Data transfer control register
MAR: Memory address register
IOAR: I/O address register
ETCR: Execute transfer count register

Figure 7.1 Block Diagram of DMAC

7.1.3 Functional Overview

Table 7.1 gives an overview of the DMAC functions.

Table 7.1 DMAC Functional Overview

Transfer Mode		Activation	Address Reg. Length	
			Source	Destination
Short address mode	I/O mode • Transfers one byte or one word per request • Increments or decrements the memory address by 1 or 2 • Executes 1 to 65,536 transfers	• Compare match/input capture A interrupts from 16-bit timer channels 0 to 2 • Transmit-data-empty interrupt from SCI channel 0	24	8
	Idle mode • Transfers one byte or one word per request • Holds the memory address fixed • Executes 1 to 65,536 transfers	• Conversion-end interrupt from A/D converter • Receive-data-full interrupt from SCI channel 0	8	24
	Repeat mode • Transfers one byte or one word per request • Increments or decrements the memory address by 1 or 2 • Executes a specified number (1 to 255) of transfers, then returns to the initial state and continues	• External request	24	8
Full address mode	Normal mode • Auto-request — Retains the transfer request internally — Executes a specified number(1 to 65,536) of transfers continuously — Selection of burst mode or cycle-steal mode • External request — Transfers one byte or one word per request — Executes 1 to 65,536 transfers	• Auto-request • External request	24	24
	Block transfer • Transfers one block of a specified size per request • Executes 1 to 65,536 transfers • Allows either the source or destination to be a fixed block area • Block size can be 1 to 255 bytes or words	• Compare match/ input capture A interrupts from 16-bit timer channels 0 to 2 • External request • Conversion-end interrupt from A/D converter	24	24

7.1.4 Input/Output Pins

Table 7.2 lists the DMAC pins.

Table 7.2 DMAC Pins

Channel	Name	Abbreviation	Input/ Output	Function
0	DMA request 0	$\overline{DREQ}_0$	Input	External request for DMAC channel 0
	Transfer end 0	$\overline{TEND}_0$	Output	Transfer end on DMAC channel 0
1	DMA request 1	$\overline{DREQ}_1$	Input	External request for DMAC channel 1
	Transfer end 1	$\overline{TEND}_1$	Output	Transfer end on DMAC channel 1

Note: External requests cannot be made to channel A in short address mode.

7.1.5 Register Configuration

Table 7.3 lists the DMAC registers.

Table 7.3 DMAC Registers

Channel	Address*	Name	Abbreviation	R/W	Initial Value
0	H'FFF20	Memory address register 0AR	MAR0AR	R/W	Undetermined
	H'FFF21	Memory address register 0AE	MAR0AE	R/W	Undetermined
	H'FFF22	Memory address register 0AH	MAR0AH	R/W	Undetermined
	H'FFF23	Memory address register 0AL	MAR0AL	R/W	Undetermined
	H'FFF26	I/O address register 0A	IOAR0A	R/W	Undetermined
	H'FFF24	Execute transfer count register 0AH	ETCR0AH	R/W	Undetermined
	H'FFF25	Execute transfer count register 0AL	ETCR0AL	R/W	Undetermined
	H'FFF27	Data transfer control register 0A	DTCR0A	R/W	H'00
	H'FFF28	Memory address register 0BR	MAR0BR	R/W	Undetermined
	H'FFF29	Memory address register 0BE	MAR0BE	R/W	Undetermined
	H'FFF2A	Memory address register 0BH	MAR0BH	R/W	Undetermined
	H'FFF2B	Memory address register 0BL	MAR0BL	R/W	Undetermined
	H'FFF2E	I/O address register 0B	IOAR0B	R/W	Undetermined
	H'FFF2C	Execute transfer count register 0BH	ETCR0BH	R/W	Undetermined
	H'FFF2D	Execute transfer count register 0BL	ETCR0BL	R/W	Undetermined
	H'FFF2F	Data transfer control register 0B	DTCR0B	R/W	H'00
1	H'FFF30	Memory address register 1AR	MAR1AR	R/W	Undetermined
	H'FFF31	Memory address register 1AE	MAR1AE	R/W	Undetermined
	H'FFF32	Memory address register 1AH	MAR1AH	R/W	Undetermined
	H'FFF33	Memory address register 1AL	MAR1AL	R/W	Undetermined
	H'FFF36	I/O address register 1A	IOAR1A	R/W	Undetermined
	H'FFF34	Execute transfer count register 1AH	ETCR1AH	R/W	Undetermined
	H'FFF35	Execute transfer count register 1AL	ETCR1AL	R/W	Undetermined
	H'FFF37	Data transfer control register 1A	DTCR1A	R/W	H'00
	H'FFF38	Memory address register 1BR	MAR1BR	R/W	Undetermined
	H'FFF39	Memory address register 1BE	MAR1BE	R/W	Undetermined
	H'FFF3A	Memory address register 1BH	MAR1BH	R/W	Undetermined
	H'FFF3B	Memory address register 1BL	MAR1BL	R/W	Undetermined
	H'FFF3E	I/O address register 1B	IOAR1B	R/W	Undetermined
	H'FFF3C	Execute transfer count register 1BH	ETCR1BH	R/W	Undetermined
	H'FFF3D	Execute transfer count register 1BL	ETCR1BL	R/W	Undetermined
	H'FFF3F	Data transfer control register 1B	DTCR1B	R/W	H'00

Note: * The lower 20 bits of the address are indicated.

7.2 Register Descriptions (1) (Short Address Mode)

In short address mode, transfers can be carried out independently on channels A and B. Short address mode is selected by bits DTS2A and DTS1A in data transfer control register A (DTCRA) as indicated in table 7.4.

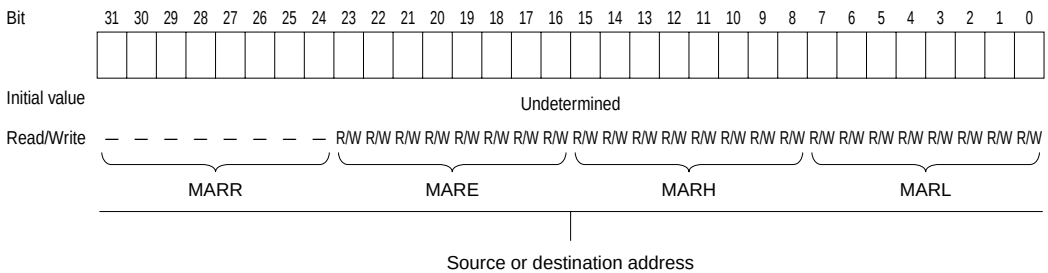
Table 7.4 Selection of Short and Full Address Modes

Channel	Bit 2 DTS2A	Bit 1 DTS1A	Description
0	1	1	DMAC channel 0 operates as one channel in full address mode
	Other than above		DMAC channels 0A and 0B operate as two independent channels in short address mode
1	1	1	DMAC channel 1 operates as one channel in full address mode
	Other than above		DMAC channels 1A and 1B operate as two independent channels in short address mode

7.2.1 Memory Address Registers (MAR)

A memory address register (MAR) is a 32-bit readable/writable register that specifies a source or destination address. The transfer direction is determined automatically from the activation source.

An MAR consists of four 8-bit registers designated MARR, MARE, MARH, and MARL. All bits of MARR are reserved; they cannot be modified and are always read as 1.



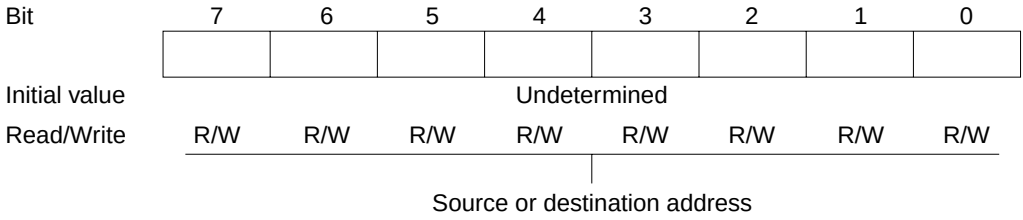
An MAR functions as a source or destination address register depending on how the DMAC is activated: as a destination address register if activation is by a receive-data-full interrupt from serial communication interface (SCI) channel 0 or by an A/D converter conversion-end interrupt, and as a source address register otherwise.

The MAR value is incremented or decremented each time one byte or word is transferred, automatically updating the source or destination memory address. For details, see section 7.3.4, Data Transfer Control Registers (DTCR).

The MARs are not initialized by a reset or in standby mode.

7.2.2 I/O Address Registers (IOAR)

An I/O address register (IOAR) is an 8-bit readable/writable register that specifies a source or destination address. The IOAR value is the lower 8 bits of the address. The upper 16 address bits are all 1 (H'FFFF).



An IOAR functions as a source or destination address register depending on how the DMAC is activated: as a destination address register if activation is by a receive-data-full interrupt from serial communication interface (SCI) channel 0 or by an A/D converter conversion-end interrupt, and as a source address register otherwise.

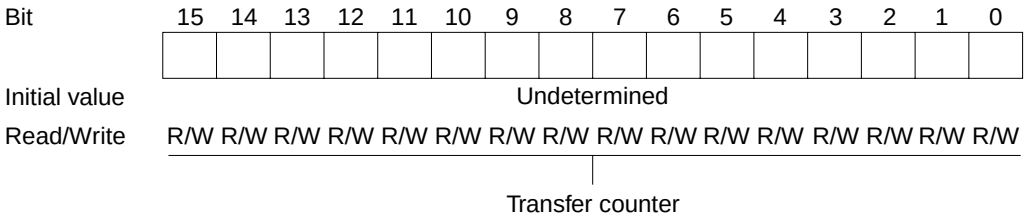
The IOAR value is held fixed. It is not incremented or decremented when a transfer is executed.

The IOARs are not initialized by a reset or in standby mode.

7.2.3 Execute Transfer Count Registers (ETCR)

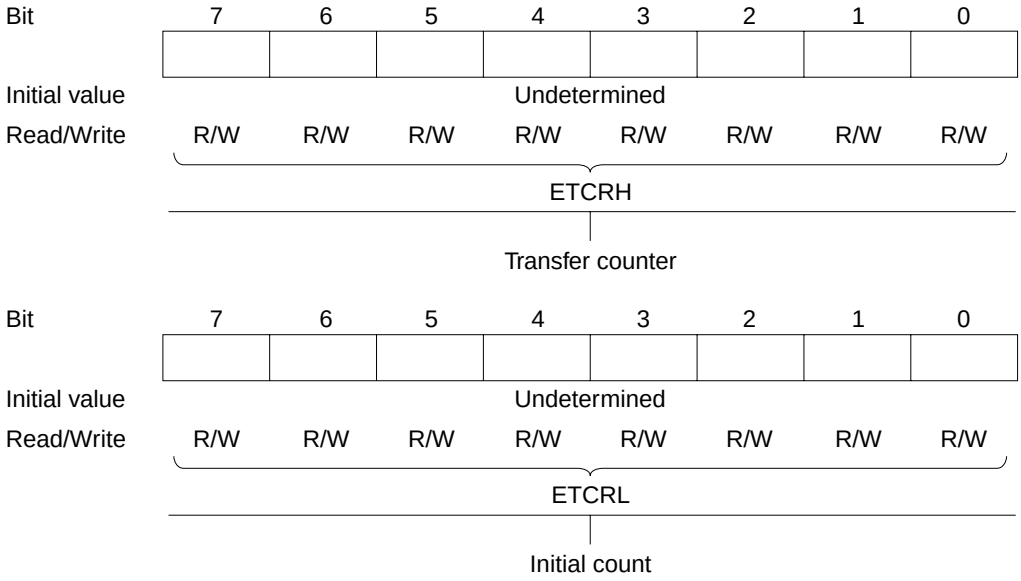
An execute transfer count register (ETCR) is a 16-bit readable/writable register that specifies the number of transfers to be executed. These registers function in one way in I/O mode and idle mode, and another way in repeat mode.

- I/O mode and idle mode



In I/O mode and idle mode, ETCR functions as a 16-bit counter. The count is decremented by 1 each time one transfer is executed. The transfer ends when the count reaches H'0000.

- Repeat mode

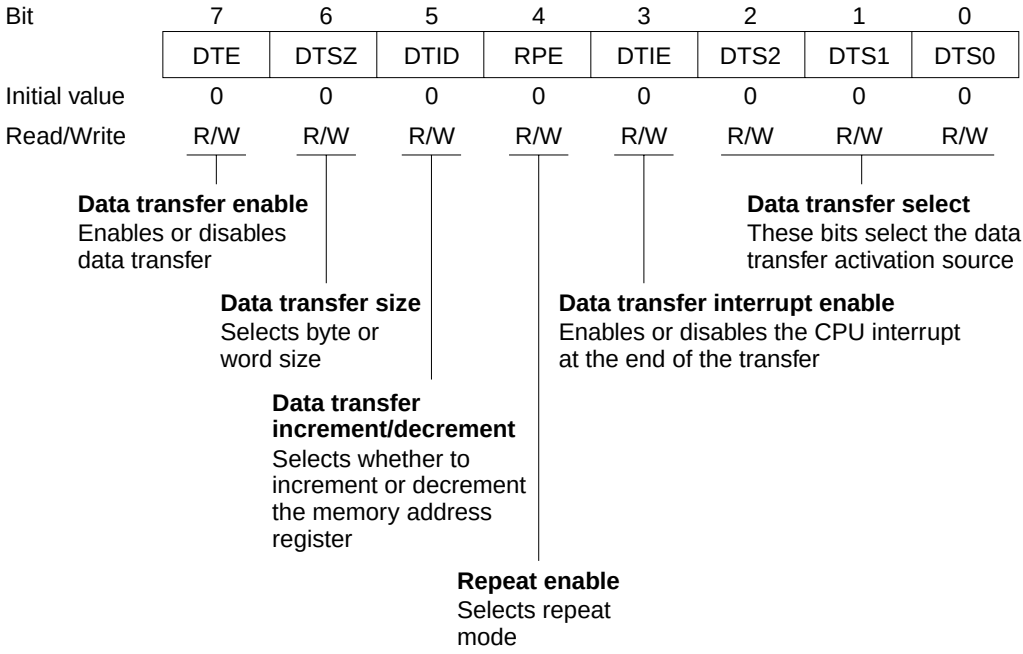


In repeat mode, ETCRH functions as an 8-bit transfer counter and ETCRL holds the initial transfer count. ETCRH is decremented by 1 each time one transfer is executed. When ETCRH reaches H'00, the value in ETCRL is reloaded into ETCRH and the same operation is repeated.

The ETCRs are not initialized by a reset or in standby mode.

7.2.4 Data Transfer Control Registers (DTCR)

A data transfer control register (DTCR) is an 8-bit readable/writable register that controls the operation of one DMAC channel.



The DTCRs are initialized to H'00 by a reset and in standby mode.

Bit 7—Data Transfer Enable (DTE): Enables or disables data transfer on a channel. When the DTE bit is set to 1, the channel waits for a transfer to be requested, and executes the transfer when activated as specified by bits DTS2 to DTS0. When DTE is 0, the channel is disabled and does not accept transfer requests. DTE is set to 1 by reading the register when DTE is 0, then writing 1.

Bit 7 DTE	Description	
0	Data transfer is disabled. In I/O mode or idle mode, DTE is cleared to 0 when the specified number of transfers have been completed	(Initial value)
1	Data transfer is enabled	

If DTIE is set to 1, a CPU interrupt is requested when DTIE is cleared to 0.

Bit 6—Data Transfer Size (DTSZ): Selects the data size of each transfer.

Bit 6 DTSZ	Description	
0	Byte-size transfer	(Initial value)
1	Word-size transfer	

Bit 5—Data Transfer Increment/Decrement (DTID): Selects whether to increment or decrement the memory address register (MAR) after a data transfer in I/O mode or repeat mode.

Bit 5 DTID	Description	
0	MAR is incremented after each data transfer	(Initial value)
	• If DTSZ = 0, MAR is incremented by 1 after each transfer	
	• If DTSZ = 1, MAR is incremented by 2 after each transfer	
1	MAR is decremented after each data transfer	
	• If DTSZ = 0, MAR is decremented by 1 after each transfer	
	• If DTSZ = 1, MAR is decremented by 2 after each transfer	

MAR is not incremented or decremented in idle mode.

Bit 4—Repeat Enable (RPE): Selects whether to transfer data in I/O mode, idle mode, or repeat mode.

Bit 4 RPE	Bit 3 DTIE	Description	
0	0	I/O mode	(Initial value)
	1		
1	0	Repeat mode	
	1	Idle mode	

Operations in these modes are described in sections 7.4.2, I/O Mode, 7.4.3, Idle Mode, and 7.4.4, Repeat Mode.

Bit 3—Data Transfer Interrupt Enable (DTIE): Enables or disables the CPU interrupt (DEND) requested when the DTE bit is cleared to 0.

Bit 3 DTIE	Description	
0	The DEND interrupt requested by DTE is disabled	(Initial value)
1	The DEND interrupt requested by DTE is enabled	

Bits 2 to 0—Data Transfer Select (DTS2, DTS1, DTS0): These bits select the data transfer activation source. Some of the selectable sources differ between channels A and B.

Bit 2 DTS2	Bit 1 DTS1	Bit 0 DTS0	Description
0	0	0	Compare match/input capture A interrupt from 16-bit timer channel 0 (Initial value)
		1	Compare match/input capture A interrupt from 16-bit timer channel 1
	1	0	Compare match/input capture A interrupt from 16-bit timer channel 2
		1	Conversion-end interrupt from A/D converter
1	0	0	Transmit-data-empty interrupt from SCI channel 0
		1	Receive-data-full interrupt from SCI channel 0
	1	0	Falling edge of $\overline{\text{DREQ}}$ input (channel B) Transfer in full address mode (channel A)
		1	Low level of $\overline{\text{DREQ}}$ input (channel B) Transfer in full address mode (channel A)

Note: See section 7.3.4, Data Transfer Control Registers (DTCR).

The same internal interrupt can be selected as an activation source for two or more channels at once. In that case the channels are activated in a priority order, highest-priority channel first. For the priority order, see section 7.4.9, Multiple-Channel Operation.

When a channel is enabled (DTE = 1), its selected DMAC activation source cannot generate a CPU interrupt.

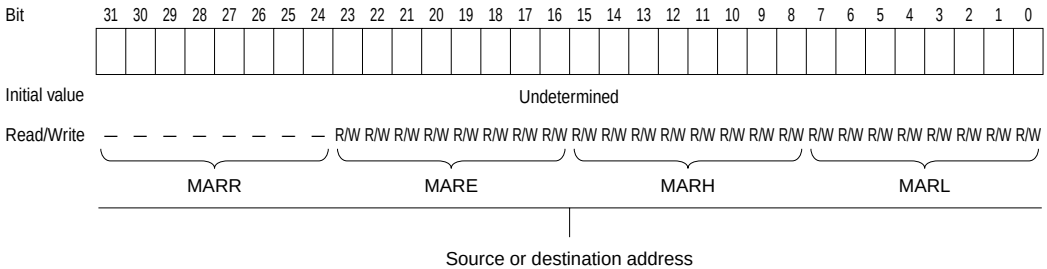
7.3 Register Descriptions (2) (Full Address Mode)

In full address mode the A and B channels operate together. Full address mode is selected as indicated in table 7.4.

7.3.1 Memory Address Registers (MAR)

A memory address register (MAR) is a 32-bit readable/writable register. MARA functions as the source address register of the transfer, and MARB as the destination address register.

An MAR consists of four 8-bit registers designated MARR, MARE, MARH, and MARL. All bits of MARR are reserved; they cannot be modified and are always read as 1. (Write is invalid.)



The MAR value is incremented or decremented each time one byte or word is transferred, automatically updating the source or destination memory address. For details, see section 7.3.4, Data Transfer Control Registers (DTCR).

The MARs are not initialized by a reset or in standby mode.

7.3.2 I/O Address Registers (IOAR)

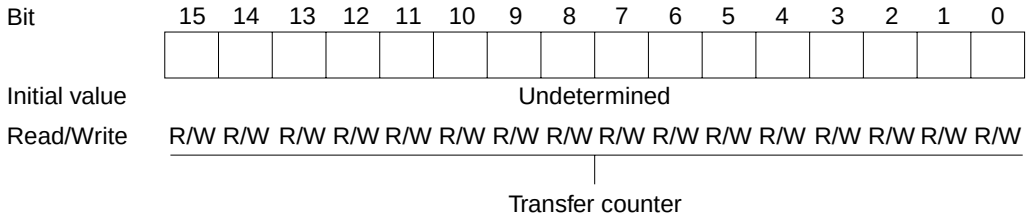
The I/O address registers (IOARs) are not used in full address mode.

7.3.3 Execute Transfer Count Registers (ETCR)

An execute transfer count register (ETCR) is a 16-bit readable/writable register that specifies the number of transfers to be executed. The functions of these registers differ between normal mode and block transfer mode.

- Normal mode

ETCRA

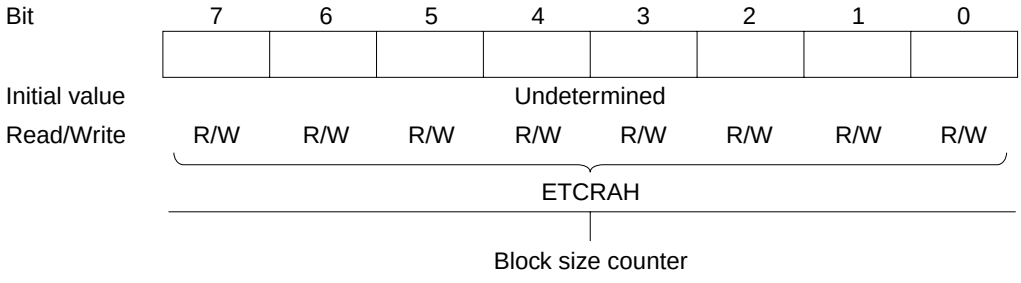


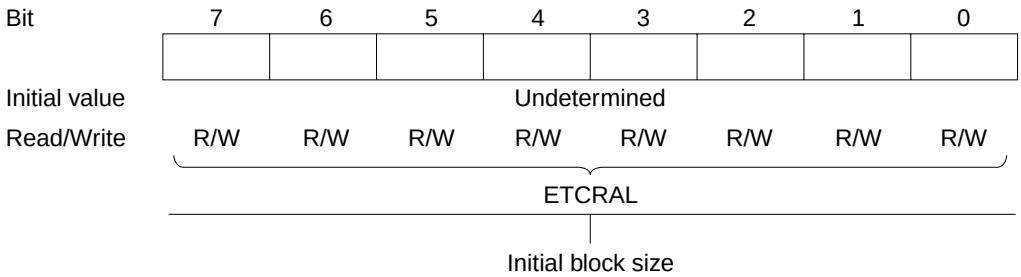
ETCRB: Is not used in normal mode.

In normal mode ETCRA functions as a 16-bit transfer counter. The count is decremented by 1 each time one transfer is executed. The transfer ends when the count reaches H'0000. ETCRB is not used.

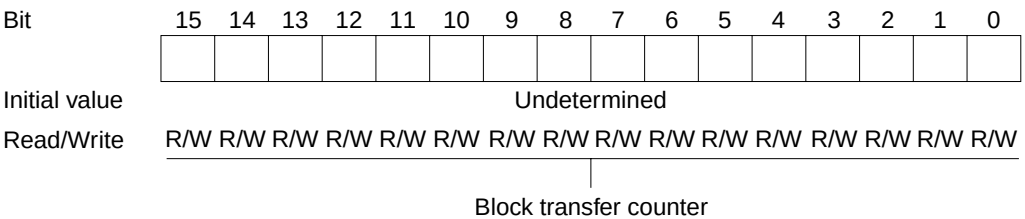
- Block transfer mode

ETCRA





ETCRB



In block transfer mode, ETCRAH functions as an 8-bit block size counter. ETCRAL holds the initial block size. ETCRAH is decremented by 1 each time one byte or word is transferred. When the count reaches H'00, ETCRAH is reloaded from ETCRAL. Blocks consisting of an arbitrary number of bytes or words can be transferred repeatedly by setting the same initial block size value in ETCRAH and ETCRAL.

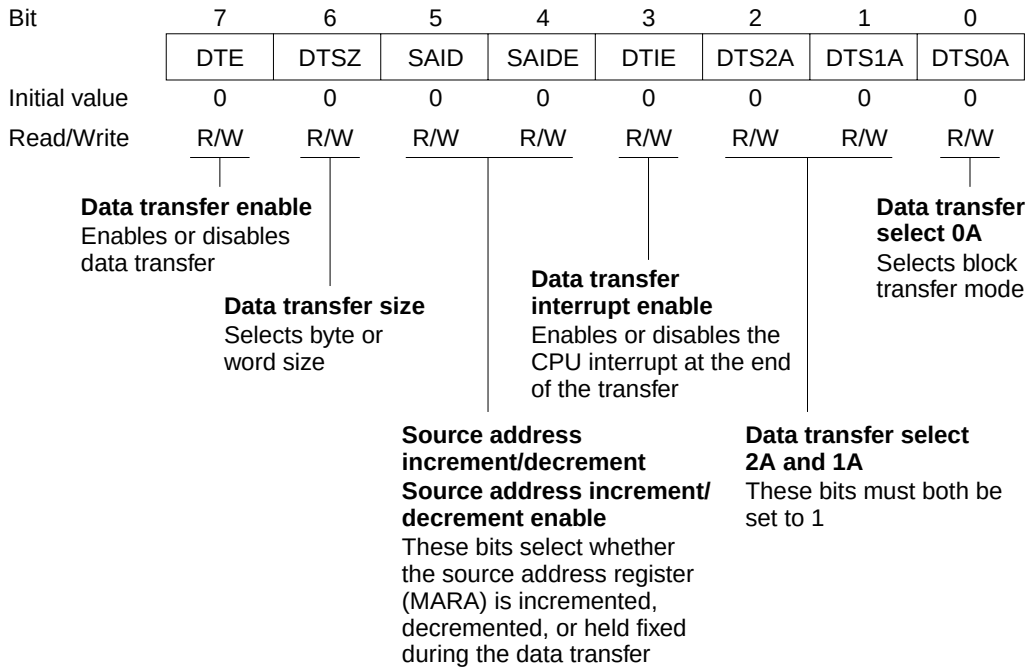
In block transfer mode ETCRB functions as a 16-bit block transfer counter. ETCRB is decremented by 1 each time one block is transferred. The transfer ends when the count reaches H'0000.

The ETCRs are not initialized by a reset or in standby mode.

7.3.4 Data Transfer Control Registers (DTCR)

The data transfer control registers (DTCRs) are 8-bit readable/writable registers that control the operation of the DMAC channels. A channel operates in full address mode when bits DTS2A and DTS1A are both set to 1 in DTCRA. DTCRA and DTCRB have different functions in full address mode.

DTCRA



DTCRA is initialized to H'00 by a reset and in standby mode.

Bit 7—Data Transfer Enable (DTE): Together with the DTME bit in DTCRB, this bit enables or disables data transfer on the channel. When the DTME and DTE bits are both set to 1, the channel is enabled. If auto-request is specified, data transfer begins immediately. Otherwise, the channel waits for transfers to be requested. When the specified number of transfers have been completed, the DTE bit is automatically cleared to 0. When DTE is 0, the channel is disabled and does not accept transfer requests. DTE is set to 1 by reading the register when DTE is 0, then writing 1.

Bit 7 DTE	Description	
0	Data transfer is disabled (DTE is cleared to 0 when the specified number of transfers have been completed)	(Initial value)
1	Data transfer is enabled	

If DTIE is set to 1, a CPU interrupt is requested when DTE is cleared to 0.

Bit 6—Data Transfer Size (DTSZ): Selects the data size of each transfer.

Bit 6 DTSZ	Description	
0	Byte-size transfer	(Initial value)
1	Word-size transfer	

Bit 5—Source Address Increment/Decrement (SAID) and,
Bit 4—Source Address Increment/Decrement Enable (SAIDE): These bits select whether the source address register (MARA) is incremented, decremented, or held fixed during the data transfer.

Bit 5 SAID	Bit 4 SAIDE	Description	
0	0	MARA is held fixed	(Initial value)
	1	MARA is incremented after each data transfer • If DTSZ = 0, MARA is incremented by 1 after each transfer • If DTSZ = 1, MARA is incremented by 2 after each transfer	
1	0	MARA is held fixed	
	1	MARA is decremented after each data transfer • If DTSZ = 0, MARA is decremented by 1 after each transfer • If DTSZ = 1, MARA is decremented by 2 after each transfer	

Bit 3—Data Transfer Interrupt Enable (DTIE): Enables or disables the CPU interrupt (DEND) requested when the DTE bit is cleared to 0.

Bit 3 DTIE	Description	
0	The DEND interrupt requested by DTE is disabled	(Initial value)
1	The DEND interrupt requested by DTE is enabled	

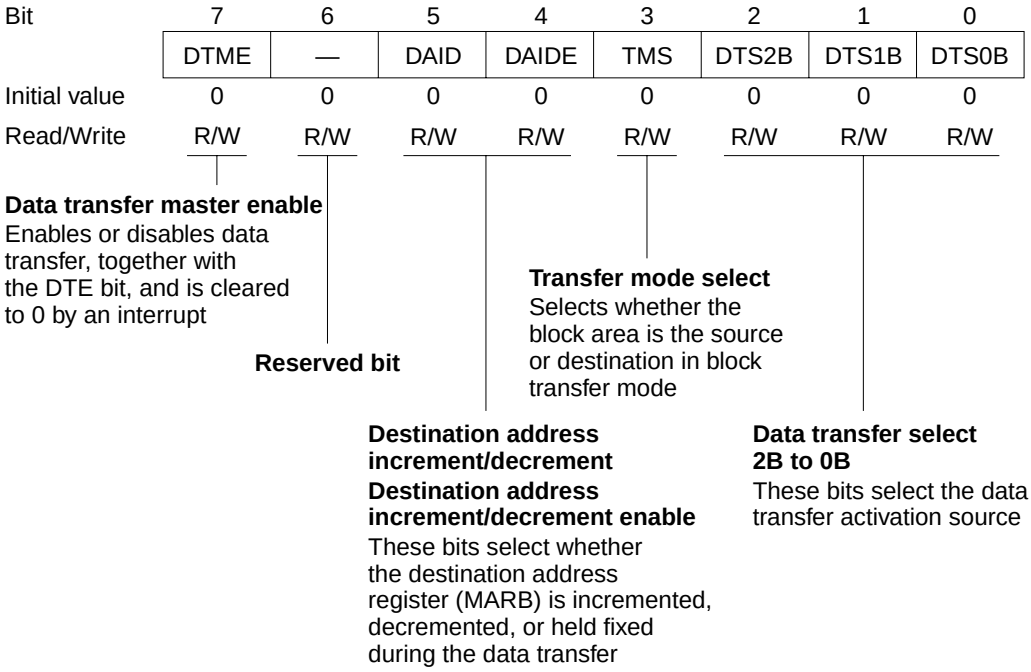
Bits 2 and 1—Data Transfer Select 2A and 1A (DTS2A, DTS1A): A channel operates in full address mode when DTS2A and DTS1A are both set to 1.

Bit 0—Data Transfer Select 0A (DTS0A): Selects normal mode or block transfer mode.

Bit 0 DTS0A	Description	
0	Normal mode	(Initial value)
1	Block transfer mode	

Operations in these modes are described in sections 7.4.5, Normal Mode, and 7.4.6, Block Transfer Mode.

DTCRB



DTCRB is initialized to H'00 by a reset and in standby mode.

Bit 7—Data Transfer Master Enable (DTME): Together with the DTE bit in DTCRA, this bit enables or disables data transfer. When the DTME and DTE bits are both set to 1, the channel is enabled. When an NMI interrupt occurs DTME is cleared to 0, suspending the transfer so that the CPU can use the bus. The suspended transfer resumes when DTME is set to 1 again. For further information on operation in block transfer mode, see section 7.6.6, NMI Interrupts and Block Transfer Mode.

DTME is set to 1 by reading the register while DTME = 0, then writing 1.

Bit 7 DTME	Description	
0	Data transfer is disabled (DTME is cleared to 0 when an NMI interrupt occurs)	(Initial value)
1	Data transfer is enabled	

Bit 6—Reserved: Although reserved, this bit can be written and read.

Bit 5—Destination Address Increment/Decrement (DAID) and,
Bit 4—Destination Address Increment/Decrement Enable (DAIDE): These bits select whether the destination address register (MARB) is incremented, decremented, or held fixed during the data transfer.

Bit 5 DAID	Bit 4 DAIDE	Description	
0	0	MARB is held fixed	(Initial value)
	1	MARB is incremented after each data transfer • If DTSZ = 0, MARB is incremented by 1 after each data transfer • If DTSZ = 1, MARB is incremented by 2 after each data transfer	
1	0	MARB is held fixed	
	1	MARB is decremented after each data transfer • If DTSZ = 0, MARB is decremented by 1 after each data transfer • If DTSZ = 1, MARB is decremented by 2 after each data transfer	

Bit 3—Transfer Mode Select (TMS): Selects whether the source or destination is the block area in block transfer mode.

Bit 3 TMS	Description	
0	Destination is the block area in block transfer mode	(Initial value)
1	Source is the block area in block transfer mode	

Bits 2 to 0—Data Transfer Select 2B to 0B (DTS2B, DTS1B, DTS0B): These bits select the data transfer activation source. The selectable activation sources differ between normal mode and block transfer mode.

Normal mode

Bit 2 DTS2B	Bit 1 DTS1B	Bit 0 DTS0B	Description
0	0	0	Auto-request (burst mode) (Initial value)
		1	Cannot be used
	1	0	Auto-request (cycle-steal mode)
		1	Cannot be used
1	0	0	Cannot be used
		1	Cannot be used
	1	0	Falling edge of $\overline{\text{DREQ}}$
		1	Low level input at $\overline{\text{DREQ}}$

Block transfer mode

Bit 2 DTS2B	Bit 1 DTS1B	Bit 0 DTS0B	Description
0	0	0	Compare match/input capture A interrupt from 16-bit timer channel 0 (Initial value)
		1	Compare match/input capture A interrupt from 16-bit timer channel 1
	1	0	Compare match/input capture A interrupt from 16-bit timer channel 2
		1	Conversion-end interrupt from A/D converter
1	0	0	Cannot be used
		1	Cannot be used
	1	0	Falling edge of $\overline{\text{DREQ}}$
		1	Cannot be used

The same internal interrupt can be selected to activate two or more channels. The channels are activated in a priority order, highest priority first. For the priority order, see section 7.4.9, Multiple-Channel Operation.

7.4 Operation

7.4.1 Overview

Table 7.5 summarizes the DMAC modes.

Table 7.5 DMAC Modes

Transfer Mode		Activation	Notes
Short address mode	I/O mode Idle mode Repeat mode	Compare match/input capture A interrupt from 16-bit timer channels 0 to 2	• Up to four channels can operate independently • Only the B channels support external requests
		Transmit-data-empty and receive-data-full interrupts from SCI channel 0	
		Conversion-end interrupt from A/D converter	
		External request	
Full address mode	Normal mode	Auto-request	• A and B channels are paired; up to two channels are available
		External request	
	Block transfer mode	Compare match/input capture A interrupt from 16-bit timer channels 0 to 2	• Burst mode transfer or cycle-steal mode transfer can be selected for auto-requests
		Conversion-end interrupt from A/D converter	
		External request	

A summary of operations in these modes follows.

I/O Mode: One byte or word is transferred per request. A designated number of these transfers are executed. A CPU interrupt can be requested at completion of the designated number of transfers. One 24-bit address and one 8-bit address are specified. The transfer direction is determined automatically from the activation source.

Idle Mode: One byte or word is transferred per request. A designated number of these transfers are executed. A CPU interrupt can be requested at completion of the designated number of transfers. One 24-bit address and one 8-bit address are specified. The addresses are held fixed. The transfer direction is determined automatically from the activation source.

Repeat Mode: One byte or word is transferred per request. A designated number of these transfers are executed. When the designated number of transfers are completed, the initial address and counter value are restored and operation continues. No CPU interrupt is requested. One 24-bit address and one 8-bit address are specified. The transfer direction is determined automatically from the activation source.

Normal Mode

- Auto-request

  The DMAC is activated by register setup alone, and continues executing transfers until the designated number of transfers have been completed. A CPU interrupt can be requested at completion of the transfers. Both addresses are 24-bit addresses.

  — Cycle-steal mode

    The bus is released to another bus master after each byte or word is transferred.

  — Burst mode

    Unless requested by a higher-priority bus master, the bus is not released until the designated number of transfers have been completed.

- External request

  One byte or word is transferred per request. A designated number of these transfers are executed. A CPU interrupt can be requested at completion of the designated number of transfers. Both addresses are 24-bit addresses.

Block Transfer Mode: One block of a specified size is transferred per request. A designated number of block transfers are executed. At the end of each block transfer, one address is restored to its initial value. When the designated number of blocks have been transferred, a CPU interrupt can be requested. Both addresses are 24-bit addresses.

7.4.2 I/O Mode

I/O mode can be selected independently for each channel.

One byte or word is transferred at each transfer request in I/O mode. A designated number of these transfers are executed. One address is specified in the memory address register (MAR), the other in the I/O address register (IOAR). The direction of transfer is determined automatically from the activation source. The transfer is from the address specified in IOAR to the address specified in MAR if activated by an SCI channel 0 receive-data-full interrupt, and from the address specified in MAR to the address specified in IOAR otherwise.

Table 7.6 indicates the register functions in I/O mode.

Table 7.6 Register Functions in I/O Mode

	Function			
Register	**Activated by SCI 0 Receive-Data-Full Interrupt**	**Other Activation**	**Initial Setting**	**Operation**
23 0 MAR	Destination address register	Source address register	Destination or source start address	Incremented or decremented once per transfer
23 7 0 All 1s | IOAR	Source address register	Destination address register	Source or destination address	Held fixed
15 0 ETCR	Transfer counter		Number of transfers	Decremented once per transfer until H'0000 is reached and transfer ends

[Legend]
MAR: Memory address register
IOAR: I/O address register
ETCR: Execute transfer count register

MAR and IOAR specify the source and destination addresses. MAR specifies a 24-bit source or destination address, which is incremented or decremented as each byte or word is transferred. IOAR specifies the lower 8 bits of a fixed address. The upper 16 bits are all 1s. IOAR is not incremented or decremented.

Figure 7.2 illustrates how I/O mode operates.

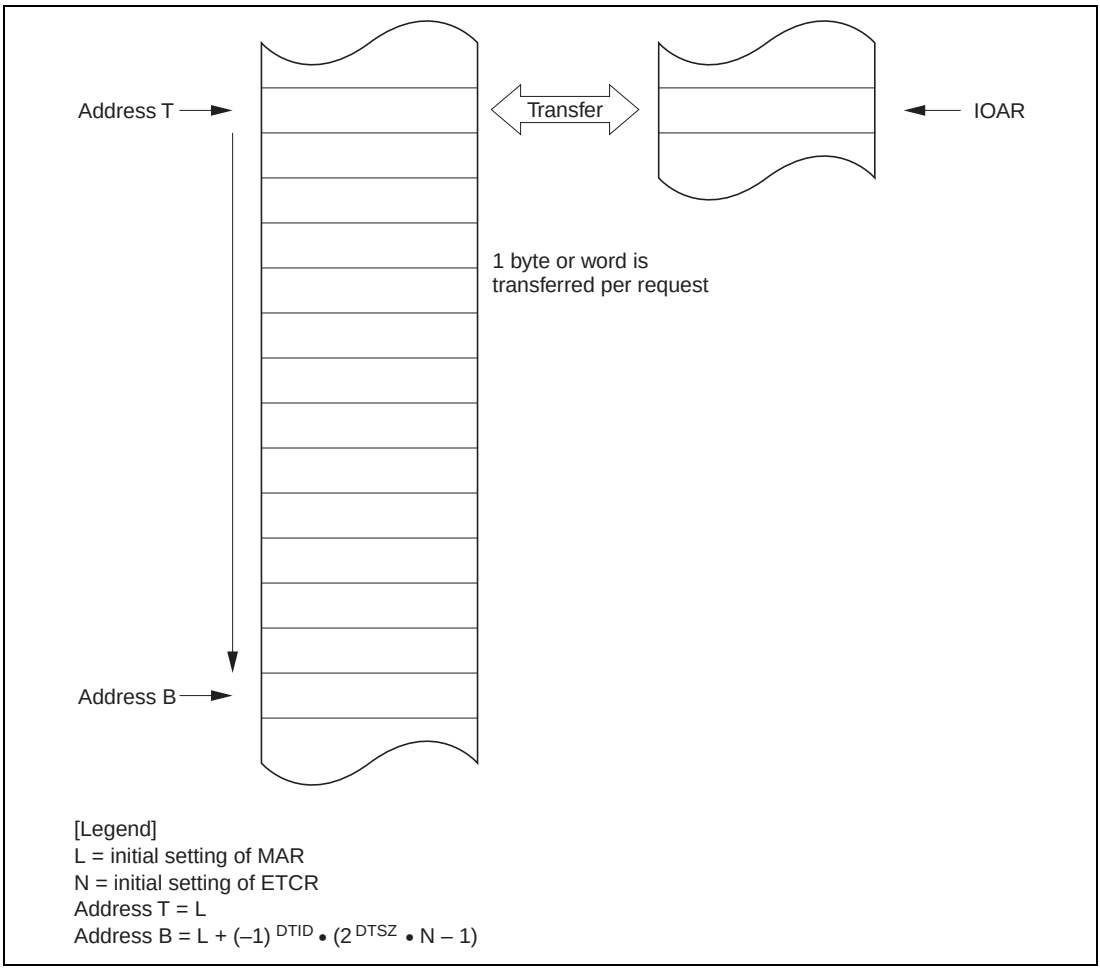


Figure 7.2 Operation in I/O Mode

The transfer count is specified as a 16-bit value in ETCR. The ETCR value is decremented by 1 at each transfer. When the ETCR value reaches H'0000, the DTE bit is cleared and the transfer ends. If the DTIE bit is set to 1, a CPU interrupt is requested at this time. The maximum transfer count is 65,536, obtained by setting ETCR to H'0000.

Transfers can be requested (activated) by compare match/input capture A interrupts from 16-bit timer channels 0 to 2, transmit-data-empty and receive-data-full interrupts from SCI channel 0, conversion-end interrupts from the A/D converter, and external request signals.

For the detailed settings see section 7.2.4, Data Transfer Control Registers (DTCR).

Figure 7.3 shows a sample setup procedure for I/O mode.

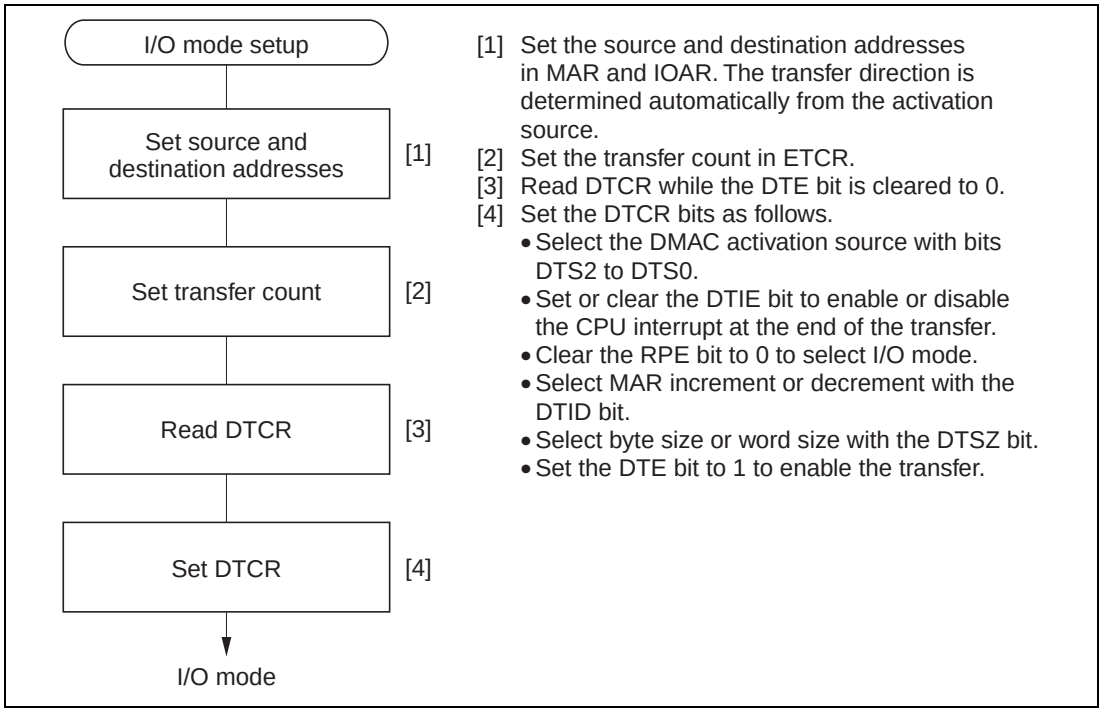


Figure 7.3 I/O Mode Setup Procedure (Example)

7.4.3 Idle Mode

Idle mode can be selected independently for each channel.

One byte or word is transferred at each transfer request in idle mode. A designated number of these transfers are executed. One address is specified in the memory address register (MAR), the other in the I/O address register (IOAR). The direction of transfer is determined automatically from the activation source. The transfer is from the address specified in IOAR to the address specified in MAR if activated by an SCI channel 0 receive-data-full interrupt, and from the address specified in MAR to the address specified in IOAR otherwise.

Table 7.7 indicates the register functions in idle mode.

Table 7.7 Register Functions in Idle Mode

Register	Function: Activated by SCI 0 Receive-Data-Full Interrupt	Function: Other Activation	Initial Setting	Operation
23 MAR 0	Destination address register	Source address register	Destination or source address	Held fixed
23 All 1s 7 IOAR 0	Source address register	Destination address register	Source or destination address	Held fixed
15 ETCR 0	Transfer counter		Number of transfers	Decremented once per transfer until H'0000 is reached and transfer ends

[Legend]
MAR: Memory address register
IOAR: I/O address register
ETCR: Execute transfer count register

MAR and IOAR specify the source and destination addresses. MAR specifies a 24-bit source or destination address. IOAR specifies the lower 8 bits of a fixed address. The upper 16 bits are all 1s. MAR and IOAR are not incremented or decremented.

Figure 7.4 illustrates how idle mode operates.

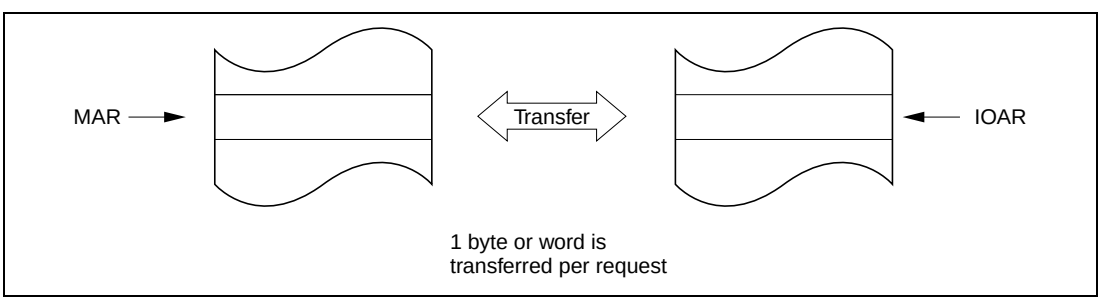


Figure 7.4 Operation in Idle Mode

The transfer count is specified as a 16-bit value in ETCR. The ETCR value is decremented by 1 at each transfer. When the ETCR value reaches H'0000, the DTE bit is cleared, the transfer ends, and a CPU interrupt is requested. The maximum transfer count is 65,536, obtained by setting ETCR to H'0000.

Transfers can be requested (activated) by compare match/input capture A interrupts from 16-bit timer channels 0 to 2, transmit-data-empty and receive-data-full interrupts from SCI channel 0, conversion-end interrupts from the A/D converter, and external request signals.

For the detailed settings see section 7.3.4, Data Transfer Control Registers (DTCR).

Figure 7.5 shows a sample setup procedure for idle mode.

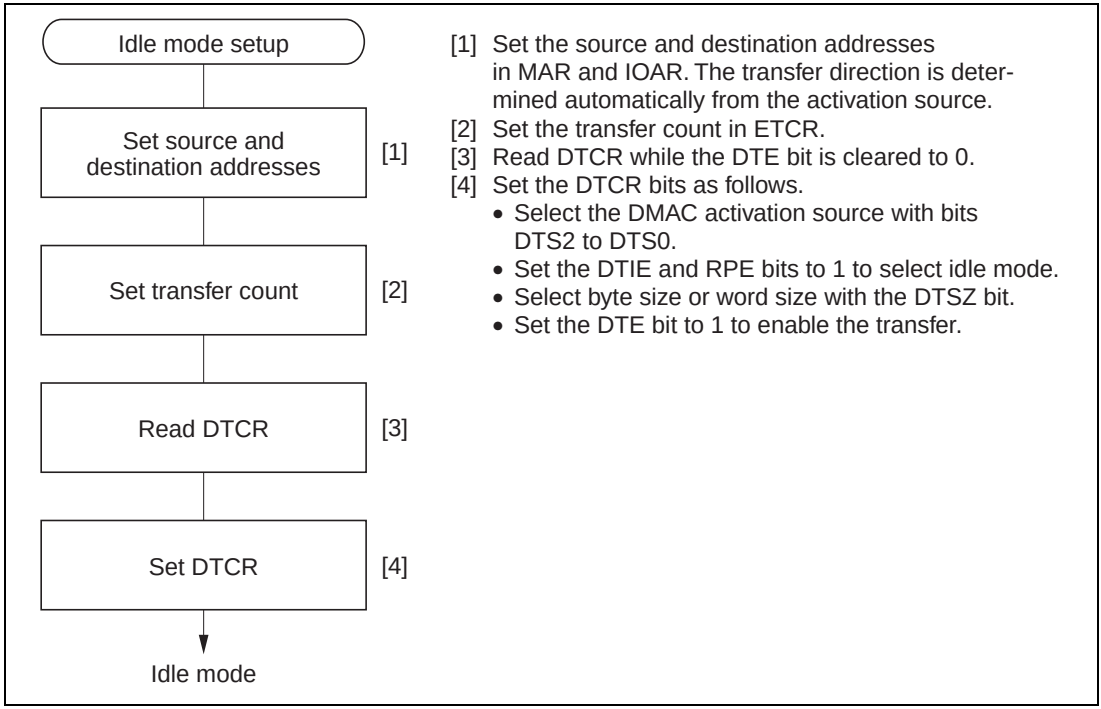


Figure 7.5 Idle Mode Setup Procedure (Example)

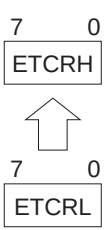
7.4.4 Repeat Mode

Repeat mode is useful for cyclically transferring a bit pattern from a table to the programmable timing pattern controller (TPC) in synchronization, for example, with 16-bit timer compare match. Repeat mode can be selected for each channel independently.

One byte or word is transferred per request in repeat mode, as in I/O mode. A designated number of these transfers are executed. One address is specified in the memory address register (MAR), the other in the I/O address register (IOAR). At the end of the designated number of transfers, MAR and ETCRH are restored to their original values and operation continues. The direction of transfer is determined automatically from the activation source. The transfer is from the address specified in IOAR to the address specified in MAR if activated by an SCI channel 0 receive-data-full interrupt, and from the address specified in MAR to the address specified in IOAR otherwise.

Table 7.8 indicates the register functions in repeat mode.

Table 7.8 Register Functions in Repeat Mode

	Function			
Register	**Activated by SCI 0 Receive-Data-Full Interrupt**	**Other Activation**	**Initial Setting**	**Operation**
	Destination address register	Source address register	Destination or source start address	Incremented or decremented at each transfer until ETCRH reaches H'0000, then restored to initial value
	Source address register	Destination address register	Source or destination address	Held fixed
	Transfer counter		Number of transfers	Decremented once per transfer until H'0000 is reached, then reloaded from ETCRL
	Initial transfer count		Number of transfers	Held fixed

[Legend]
MAR: Memory address register
IOAR: I/O address register
ETCR: Execute transfer count register

In repeat mode ETCRH is used as the transfer counter while ETCRL holds the initial transfer count. ETCRH is decremented by 1 at each transfer until it reaches H'00, then is reloaded from ETCRL. MAR is also restored to its initial value, which is calculated from the DTSZ and DTID bits in DTCR. Specifically, MAR is restored as follows:

$$MAR \leftarrow MAR - (-1)^{DTID} \cdot 2^{DTSZ} \cdot ETCRL$$

ETCRH and ETCRL should be initially set to the same value.

In repeat mode transfers continue until the CPU clears the DTE bit to 0. After DTE is cleared to 0, if the CPU sets DTE to 1 again, transfers resume from the state at which DTE was cleared. No CPU interrupt is requested.

As in I/O mode, MAR and IOAR specify the source and destination addresses. MAR specifies a 24-bit source or destination address. IOAR specifies the lower 8 bits of a fixed address. The upper 16 bits are all 1s. IOAR is not incremented or decremented.

Figure 7.6 illustrates how repeat mode operates.

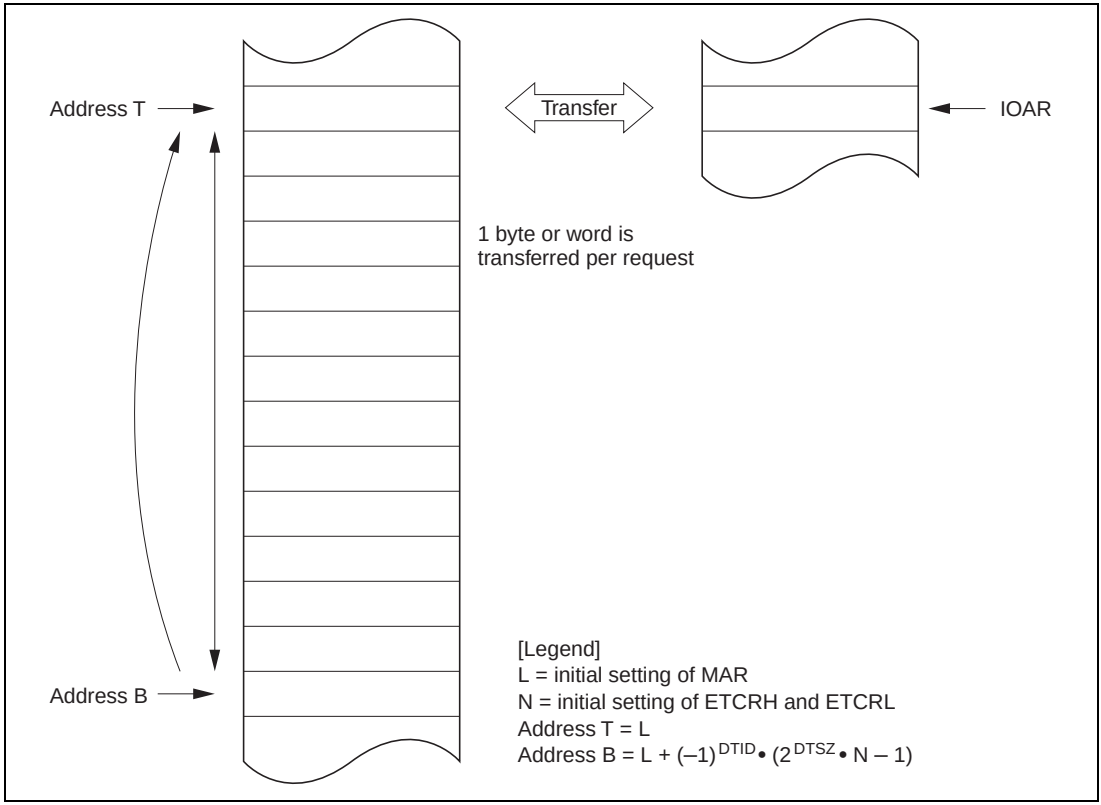


Figure 7.6 Operation in Repeat Mode

The transfer count is specified as an 8-bit value in ETCRH and ETCRL. The maximum transfer count is 255, obtained by setting both ETCRH and ETCRL to H'FF.

Transfers can be requested (activated) by compare match/input capture A interrupts from 16-bit timer channels 0 to 2, transmit-data-empty and receive-data-full interrupts from SCI channel 0, conversion-end interrupts from the A/D converter, and external request signals.

For the detailed settings see section 7.2.4, Data Transfer Control Registers (DTCR).

Figure 7.7 shows a sample setup procedure for repeat mode.

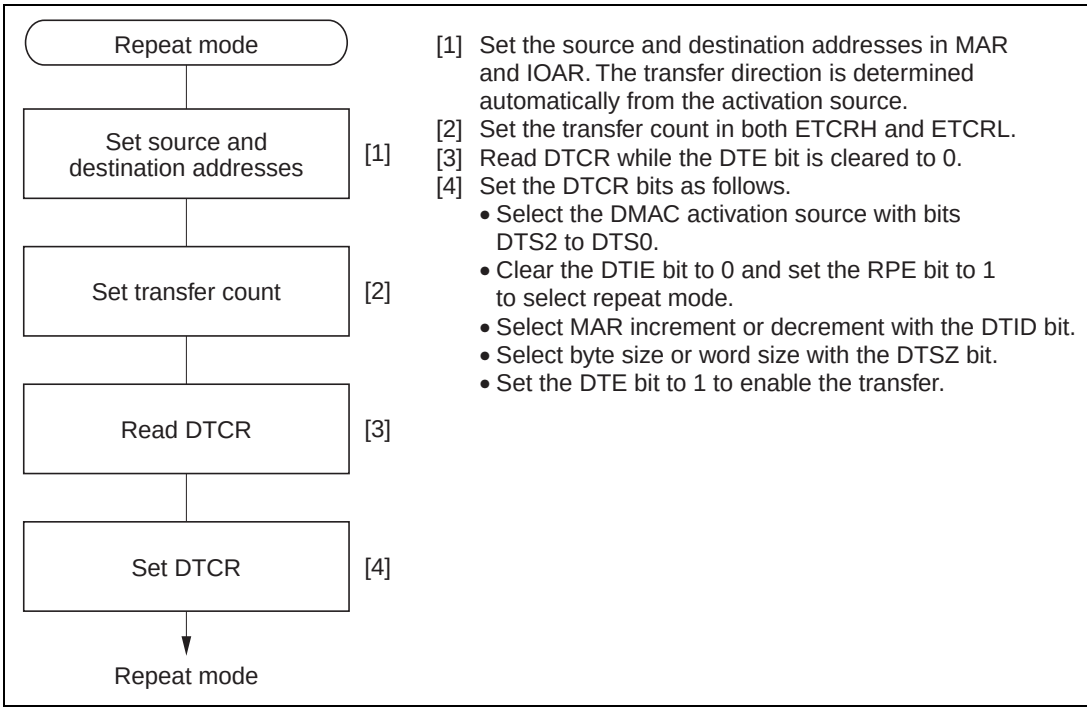


Figure 7.7 Repeat Mode Setup Procedure (Example)

7.4.5 Normal Mode

In normal mode the A and B channels are combined. One byte or word is transferred per request. A designated number of these transfers are executed. Addresses are specified in MARA and MARB. Table 7.9 indicates the register functions in I/O mode.

Table 7.9 Register Functions in Normal Mode

Register	Function	Initial Setting	Operation
	Source address register	Source start address	Incremented or decremented once per transfer, or held fixed
	Destination address register	Destination start address	Incremented or decremented once per transfer, or held fixed
	Transfer counter	Number of transfers	Decremented once per transfer

[Legend]
MARA: Memory address register A
MARB: Memory address register B
ETCRA: Execute transfer count register A

The source and destination addresses are both 24-bit addresses. MARA specifies the source address. MARB specifies the destination address. MARA and MARB can be independently incremented, decremented, or held fixed as data is transferred.

The transfer count is specified as a 16-bit value in ETCRA. The ETCRA value is decremented by 1 at each transfer. When the ETCRA value reaches H'0000, the DTE bit is cleared and the transfer ends. If the DTIE bit is set to 1, a CPU interrupt is requested at this time. The maximum transfer count is 65,536, obtained by setting ETCRA to H'0000.

Figure 7.8 illustrates how normal mode operates.

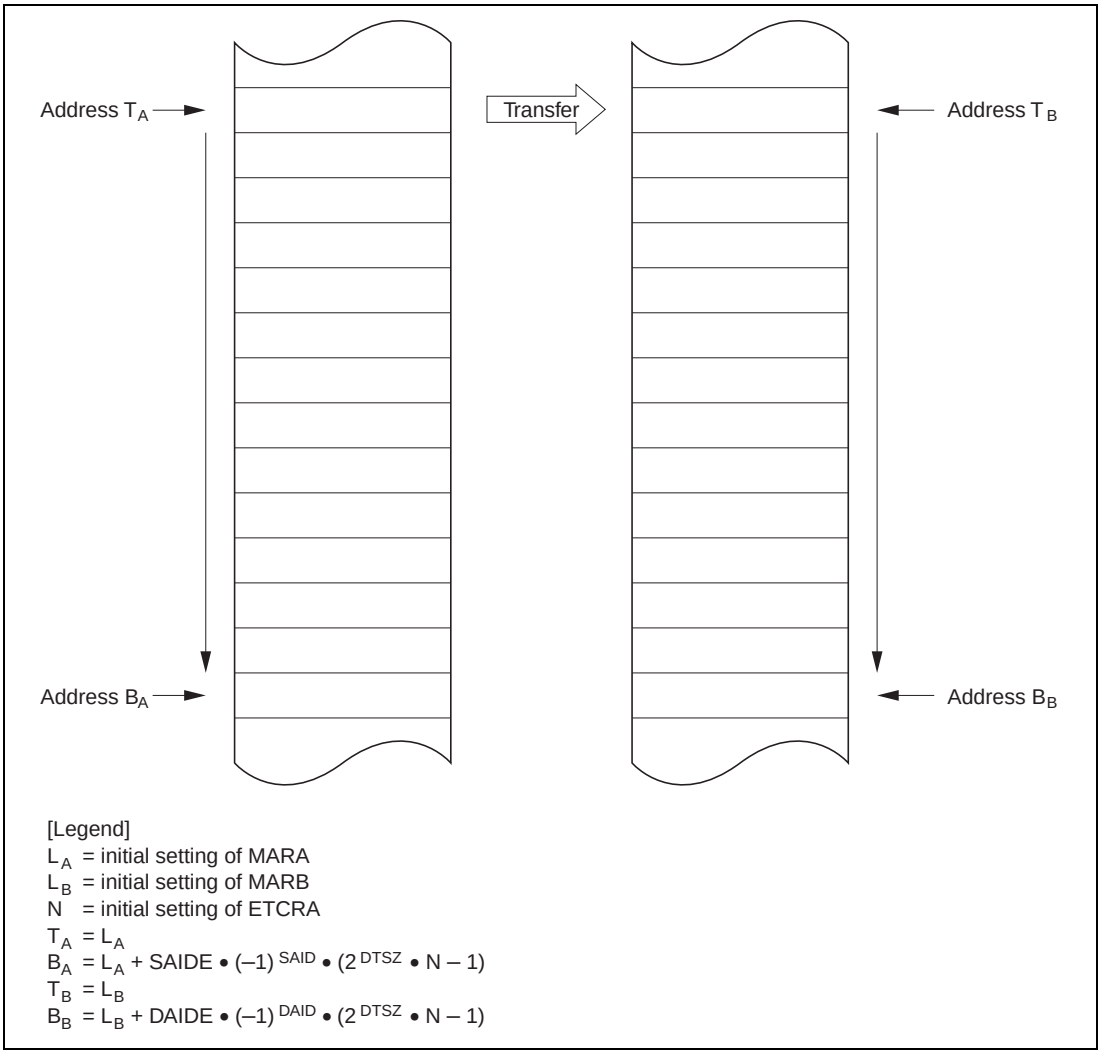
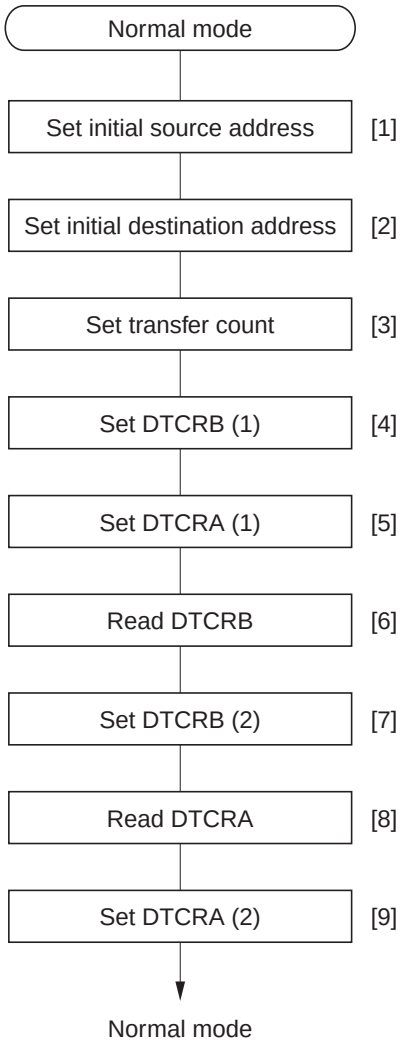


Figure 7.8 Operation in Normal Mode

Transfers can be requested (activated) by an external request or auto-request. An auto-requested transfer is activated by the register settings alone. The designated number of transfers are executed automatically. Either cycle-steal or burst mode can be selected. In cycle-steal mode the DMAC releases the bus temporarily after each transfer. In burst mode the DMAC keeps the bus until the transfers are completed, unless there is a bus request from a higher-priority bus master.

For the detailed settings see section 7.3.4, Data Transfer Control Registers (DTCR).

Figure 7.9 shows a sample setup procedure for normal mode.



[1] Set the initial source address in MARA.
[2] Set the initial destination address in MARB.
[3] Set the transfer count in ETCRA.
[4] Set the DTCRB bits as follows.
- Clear the DTME bit to 0.
- Set the DAID and DAIDE bits to select whether MARB is incremented, decremented, or held fixed.
- Select the DMAC activation source with bits DTS2B to DTS0B.

[5] Set the DTCRA bits as follows.
- Clear the DTE bit to 0.
- Select byte or word size with the DTSZ bit.
- Set the SAID and SAIDE bits to select whether MARA is incremented, decremented, or held fixed.
- Set or clear the DTIE bit to enable or disable the CPU interrupt at the end of the transfer.
- Clear the DTS0A bit to 0 and set the DTS2A and DTS1A bits to 1 to select normal mode.

[6] Read DTCRB with DTME cleared to 0.
[7] Set the DTME bit to 1 in DTCRB.
[8] Read DTCRA with DTE cleared to 0.
[9] Set the DTE bit to 1 in DTCRA to enable the transfer.

Note: Carry out settings 1 to 9 with the DEND interrupt masked in the CPU.
If an NMI interrupt occurs during the setup procedure, it may clear the DTME bit to 0, in which case the transfer will not start.

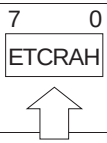
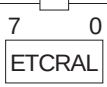
Figure 7.9 Normal Mode Setup Procedure (Example)

7.4.6 Block Transfer Mode

In block transfer mode the A and B channels are combined. One block of a specified size is transferred per request. A designated number of block transfers are executed. Addresses are specified in MARA and MARB. The block area address can be either held fixed or cycled.

Table 7.10 indicates the register functions in block transfer mode.

Table 7.10 Register Functions in Block Transfer Mode

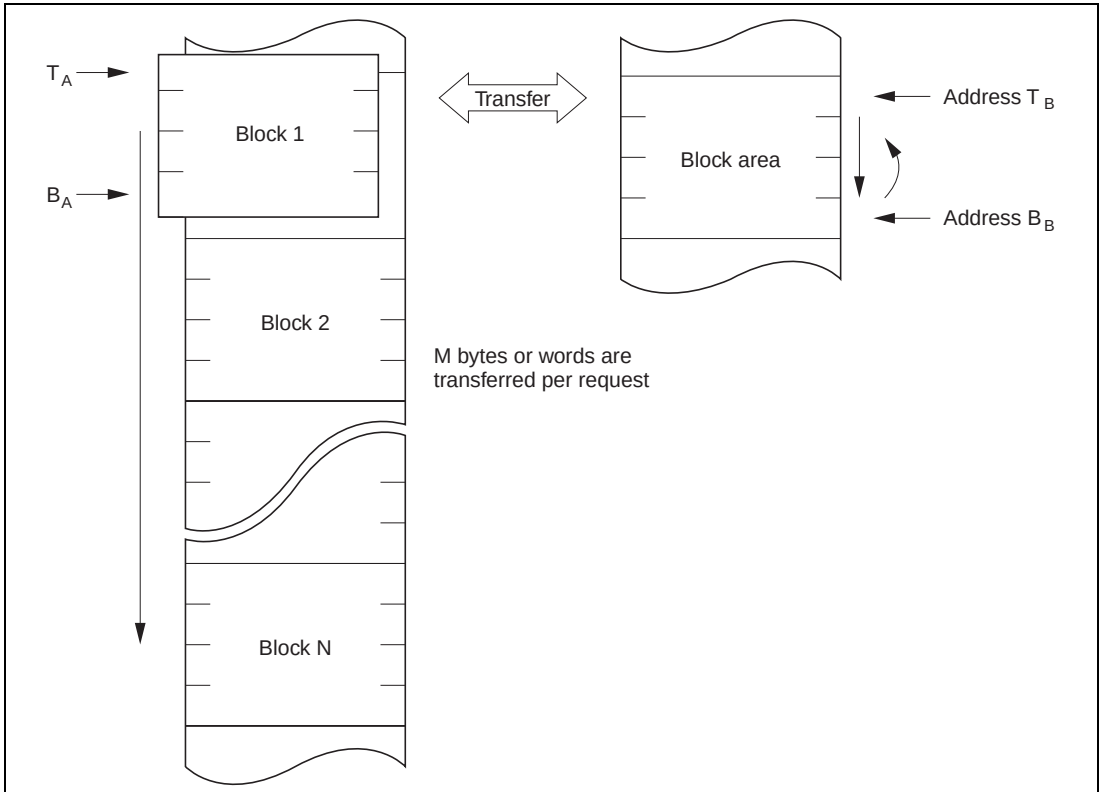
Register	Function	Initial Setting	Operation
	Source address register	Source start address	Incremented or decremented once per transfer, or held fixed
	Destination address register	Destination start address	Incremented or decremented once per transfer, or held fixed
	Block size counter	Block size	Decremented once per transfer until H'00 is reached, then reloaded from ETCRL
	Initial block size	Block size	Held fixed
	Block transfer counter	Number of block transfers	Decremented once per block transfer until H'0000 is reached and the transfer ends

[Legend]
MARA: Memory address register A
MARB: Memory address register B
ETCRA: Execute transfer count register A
ETCRB: Execute transfer count register B

The source and destination addresses are both 24-bit addresses. MARA specifies the source address. MARB specifies the destination address. MARA and MARB can be independently incremented, decremented, or held fixed as data is transferred. One of these registers operates as a block area register: even if it is incremented or decremented, it is restored to its initial value at the end of each block transfer. The TMS bit in DTCRB selects whether the block area is the source or destination.

If M (1 to 255) is the size of the block transferred at each request and N (1 to 65,536) is the number of blocks to be transferred, then ETCRAH and ETCRAL should initially be set to M and ETCRB should initially be set to N.

Figure 7.10 illustrates how block transfer mode operates. In this figure, bit TMS is cleared to 0, meaning the block area is the destination.



[Legend]
L_A = initial setting of MARA
L_B = initial setting of MARB
M = initial setting of ETCRAH and ETCRAL
N = initial setting of ETCRB
$T_A = L_A$
$B_A = L_A + SAIDE \bullet (-1)^{SAID} \bullet (2^{DTSZ} \bullet M - 1)$
$T_B = L_B$
$B_B = L_B + DAIDE \bullet (-1)^{DAID} \bullet (2^{DTSZ} \bullet M - 1)$

Figure 7.10 Operation in Block Transfer Mode

When activated by a transfer request, the DMAC executes a burst transfer. During the transfer MARA and MARB are updated according to the DTCR settings, and ETCRAH is decremented. When ETCRAH reaches H'00, it is reloaded from ETCRAL to restore the initial value. The memory address register of the block area is also restored to its initial value, and ETCRB is decremented. If ETCRB is not H'0000, the DMAC then waits for the next transfer request. ETCRAH and ETCRAL should be initially set to the same value.

The above operation is repeated until ETCRB reaches H'0000, at which point the DTE bit is cleared to 0 and the transfer ends. If the DTIE bit is set to 1, a CPU interrupt is requested at this time.

Figure 7.11 shows examples of a block transfer with byte data size when the block area is the destination. In (a) the block area address is cycled. In (b) the block area address is held fixed.

Transfers can be requested (activated) by compare match/input capture A interrupts from ITU channels 0 to 2, by an A/D converter conversion-end interrupt, and by external request signals.

For the detailed settings see section 7.3.4, Data Transfer Control Registers (DTCR).

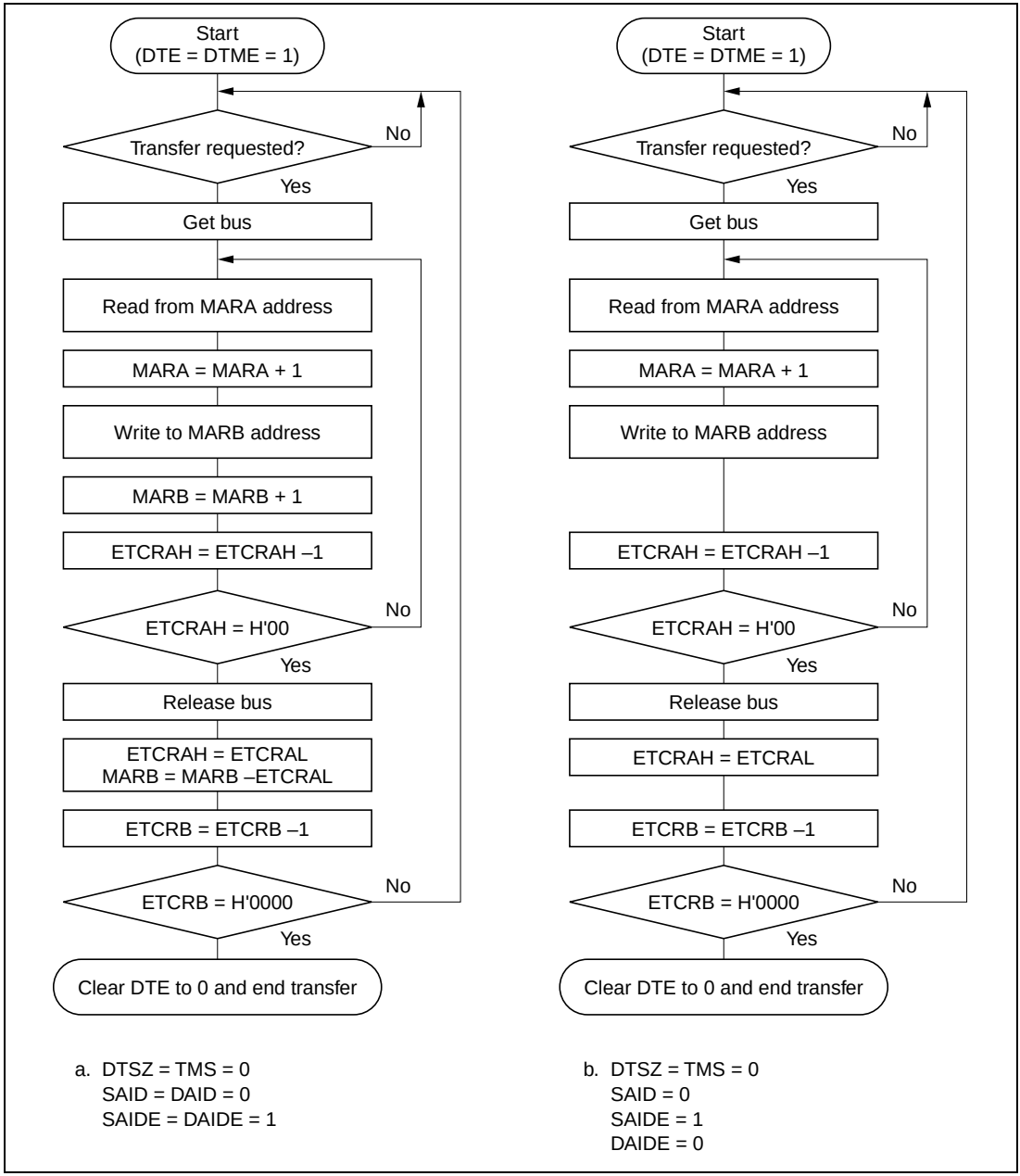
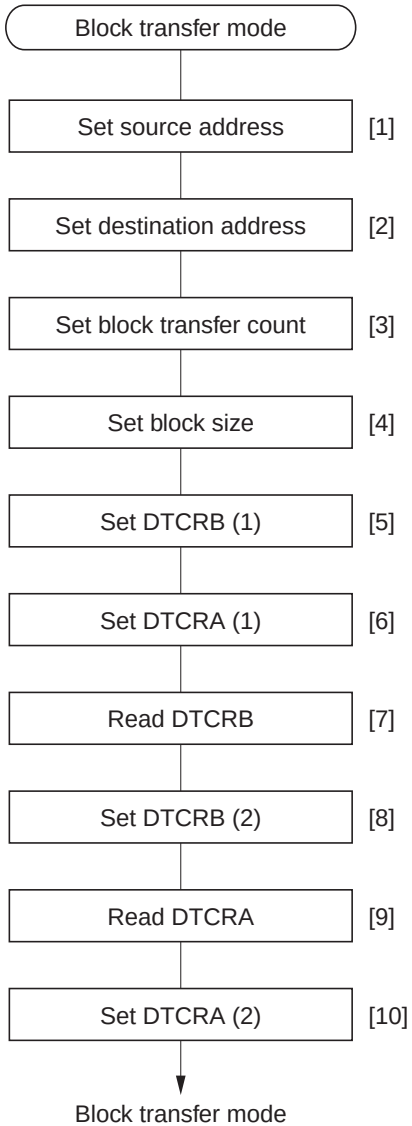


Figure 7.11 Block Transfer Mode Flowcharts (Examples)

Figure 7.12 shows a sample setup procedure for block transfer mode.



[1] Set the source address in MARA.
[2] Set the destination address in MARB.
[3] Set the block transfer count in ETCRB.
[4] Set the block size (number of bytes or words) in both ETCRAH and ETCRAL.
[5] Set the DTCRB bits as follows.
- Clear the DTME bit to 0.
- Set the DAID and DAIDE bits to select whether MARB is incremented, decremented, or held fixed.
- Set or clear the TMS bit to make the block area the source or destination.
- Select the DMAC activation source with bits DTS2B to DTS0B.

[6] Set the DTCRA bits as follows.
- Clear the DTE to 0.
- Select byte size or word size with the DTSZ bit.
- Set the SAID and SAIDE bits to select whether MARA is incremented, decremented, or held fixed.
- Set or clear the DTIE bit to enable or disable the CPU interrupt at the end of the transfer.
- Set bits DTS2A to DTS0A all to 1 to select block transfer mode.

[7] Read DTCRB with DTME cleared to 0.
[8] Set the DTME bit to 1 in DTCRB.
[9] Read DTCRA with DTE cleared to 0.
[10] Set the DTE bit to 1 in DTCRA to enable the transfer.

Note: Carry out settings 1 to 10 with the DEND interrupt masked in the CPU.
If an NMI interrupt occurs during the setup procedure, it may clear the DTME bit to 0, in which case the transfer will not start.

Figure 7.12 Block Transfer Mode Setup Procedure (Example)

7.4.7 DMAC Activation

The DMAC can be activated by an internal interrupt, external request, or auto-request. The available activation sources differ depending on the transfer mode and channel as indicated in table 7.11.

Table 7.11 DMAC Activation Sources

		Short Address Mode			
		Channels	Channels	Full Address Mode	
Activation Source		0A and 1A	0B and 1B	Normal	Block
Internal interrupts	IMIA0	○	○	×	○
	IMIA1	○	○	×	○
	IMIA2	○	○	×	○
	ADI	○	○	×	○
	TXI0	○	○	×	×
	RXI0	○	○	×	×
External requests	Falling edge of $\overline{\text{DREQ}}$	×	○	○	○
	Low input at $\overline{\text{DREQ}}$	×	○	○	×
Auto-request		×	×	○	×

Activation by Internal Interrupts: When an interrupt request is selected as a DMAC activation source and the DTE bit is set to 1, that interrupt request is not sent to the CPU. It is not possible for an interrupt request to activate the DMAC and simultaneously generate a CPU interrupt.

When the DMAC is activated by an interrupt request, the interrupt request flag is cleared automatically. If the same interrupt is selected to activate two or more channels, the interrupt request flag is cleared when the highest-priority channel is activated, but the transfer request is held pending on the other channels in the DMAC, which are activated in their priority order.

Activation by External Request: If an external request ($\overline{\text{DREQ}}$ pin) is selected as an activation source, the $\overline{\text{DREQ}}$ pin becomes an input pin and the corresponding $\overline{\text{TEND}}$ pin becomes an output pin, regardless of the port data direction register (DDR) settings. The $\overline{\text{DREQ}}$ input can be level-sensitive or edge-sensitive.

In short address mode and normal mode, an external request operates as follows. If edge sensing is selected, one byte or word is transferred each time a high-to-low transition of the $\overline{\text{DREQ}}$ input is detected. If the next edge is input before the transfer is completed, the next transfer may not be executed. If level sensing is selected, the transfer continues while $\overline{\text{DREQ}}$ is low, until the transfer is completed. The bus is released temporarily after each byte or word has been transferred, however. If the $\overline{\text{DREQ}}$ input goes high during a transfer, the transfer is suspended after the current byte or word has been transferred. When $\overline{\text{DREQ}}$ goes low, the request is held internally until one byte or word has been transferred. The $\overline{\text{TEND}}$ signal goes low during the last write cycle.

In block transfer mode, an external request operates as follows. Only edge-sensitive transfer requests are possible in block transfer mode. Each time a high-to-low transition of the $\overline{\text{DREQ}}$ input is detected, a block of the specified size is transferred. The $\overline{\text{TEND}}$ signal goes low during the last write cycle in each block.

Activation by Auto-Request: The transfer starts as soon as enabled by register setup, and continues until completed. Cycle-steal mode or burst mode can be selected.

In cycle-steal mode the DMAC releases the bus temporarily after transferring each byte or word. Normally, DMAC cycles alternate with CPU cycles.

In burst mode the DMAC keeps the bus until the transfer is completed, unless there is a higher-priority bus request. If there is a higher-priority bus request, the bus is released after the current byte or word has been transferred.

7.4.8 DMAC Bus Cycle

Figure 7.13 shows an example of the timing of the basic DMAC bus cycle. This example shows a word-size transfer from a 16-bit two-state access area to an 8-bit three-state access area. When the DMAC gets the bus from the CPU, after one dead cycle (T_d), it reads from the source address and writes to the destination address. During these read and write operations the bus is not released even if there is another bus request. DMAC cycles comply with bus controller settings in the same way as CPU cycles.

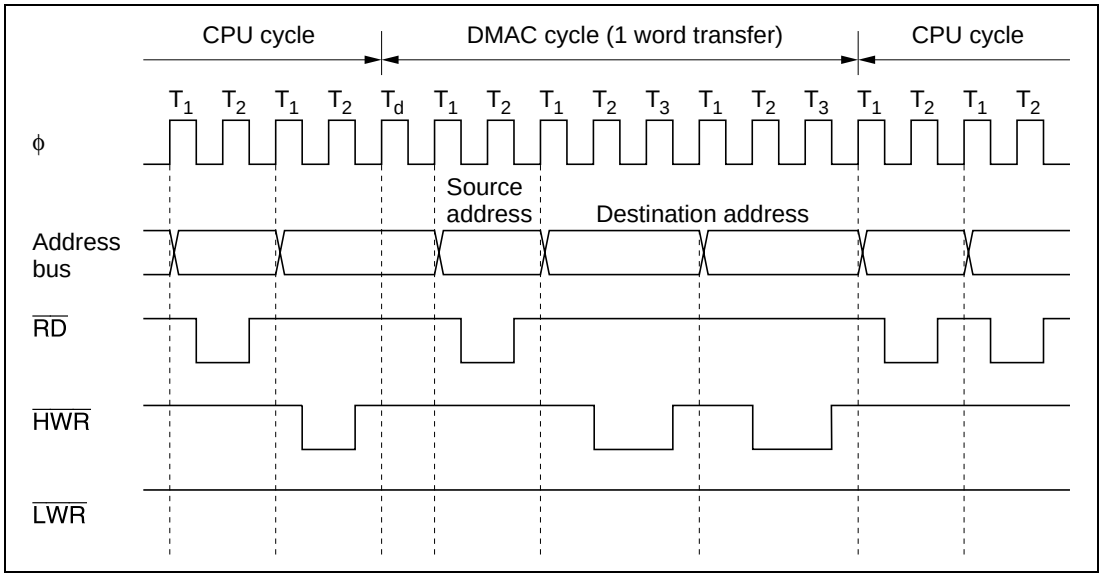


Figure 7.13 DMA Transfer Bus Timing (Example)

Figure 7.14 shows the timing when the DMAC is activated by low input at a $\overline{\text{DREQ}}$ pin. This example shows a word-size transfer from a 16-bit two-state access area to another 16-bit two-state access area. The DMAC continues the transfer while the $\overline{\text{DREQ}}$ pin is held low.

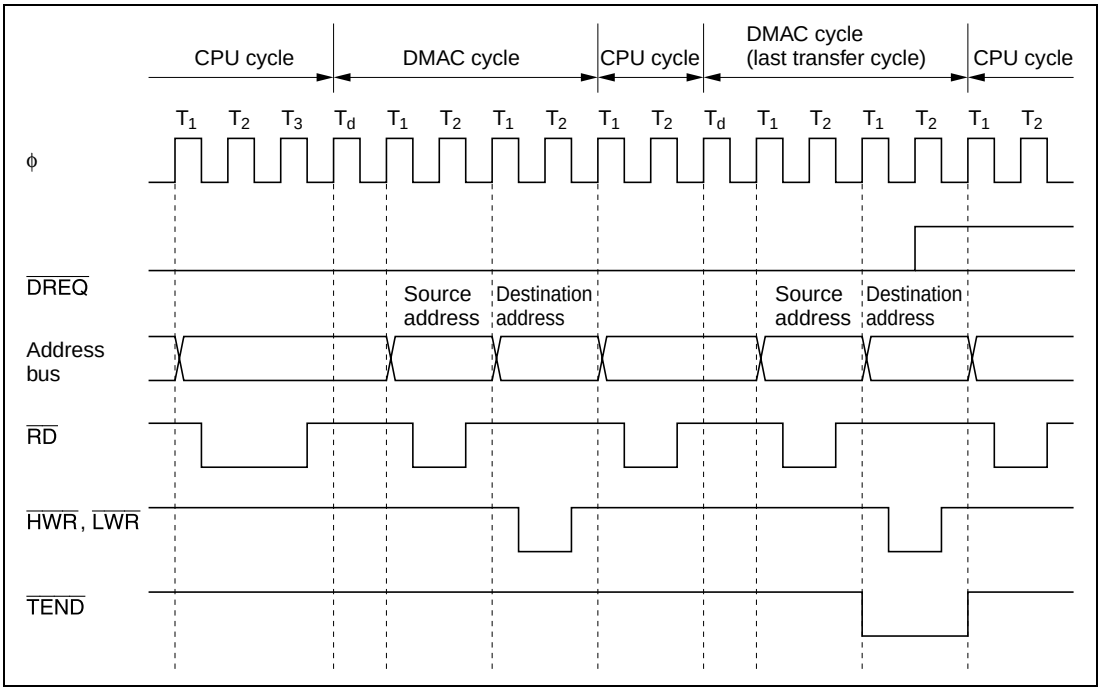


Figure 7.14 Bus Timing of DMA Transfer Requested by Low $\overline{\text{DREQ}}$ Input

Figure 7.15 shows an auto-requested burst-mode transfer. This example shows a transfer of three words from a 16-bit two-state access area to another 16-bit two-state access area.

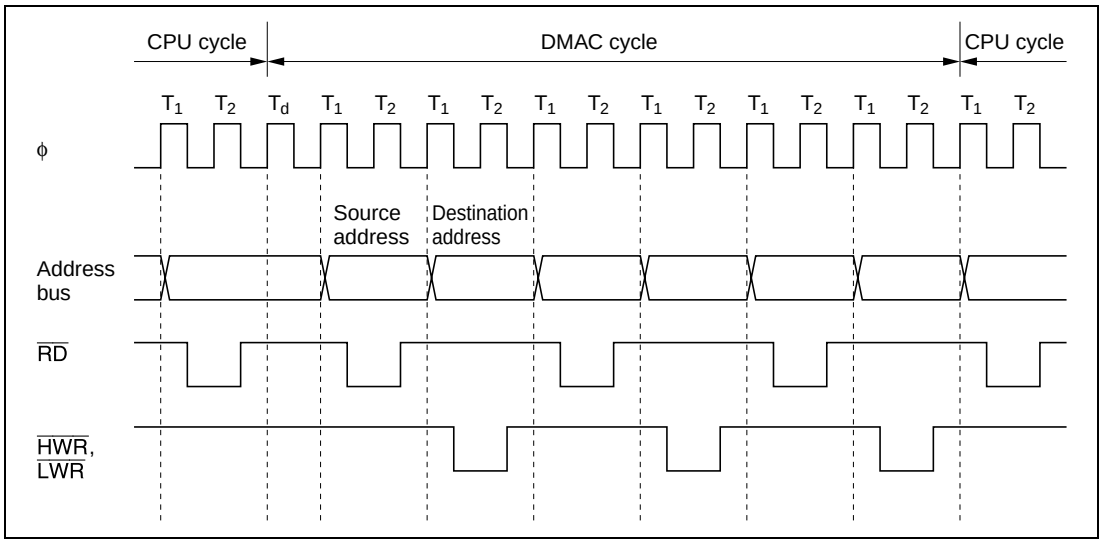


Figure 7.15 Burst DMA Bus Timing

When the DMAC is activated from a $\overline{\text{DREQ}}$ pin there is a minimum interval of four states from when the transfer is requested until the DMAC starts operating. The $\overline{\text{DREQ}}$ pin is not sampled during the time between the transfer request and the start of the transfer. In short address mode and normal mode, the pin is next sampled at the end of the read cycle. In block transfer mode, the pin is next sampled at the end of one block transfer.

Figure 7.16 shows the timing when the DMAC is activated by the falling edge of $\overline{\text{DREQ}}$ in normal mode.

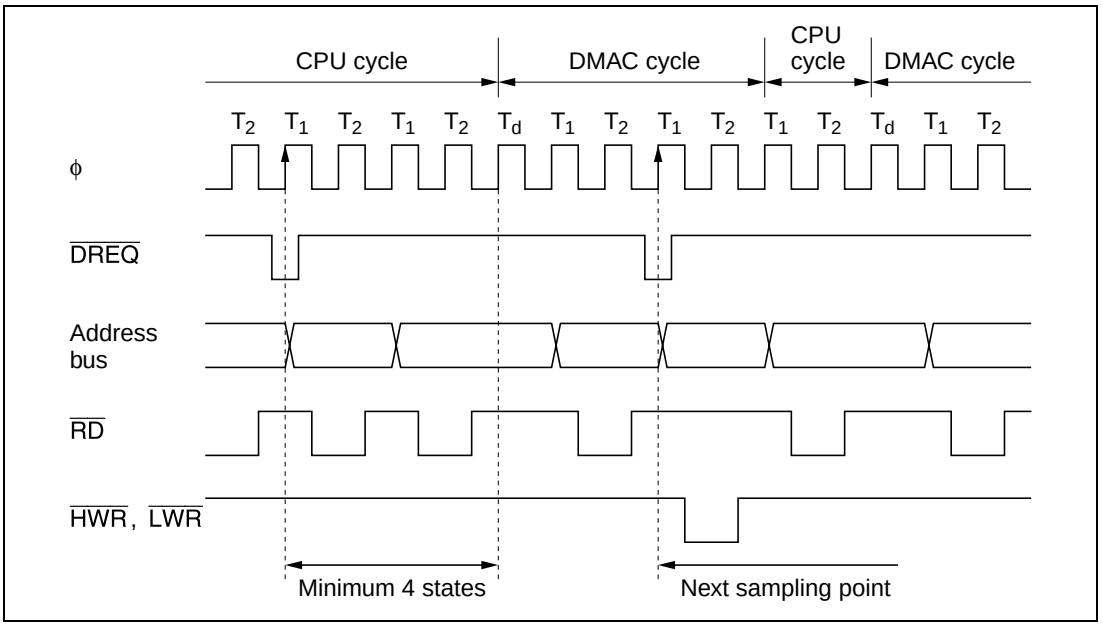


Figure 7.16 Timing of DMAC Activation by Falling Edge of $\overline{\text{DREQ}}$ in Normal Mode

Figure 7.17 shows the timing when the DMAC is activated by level-sensitive low $\overline{\text{DREQ}}$ input in normal mode.

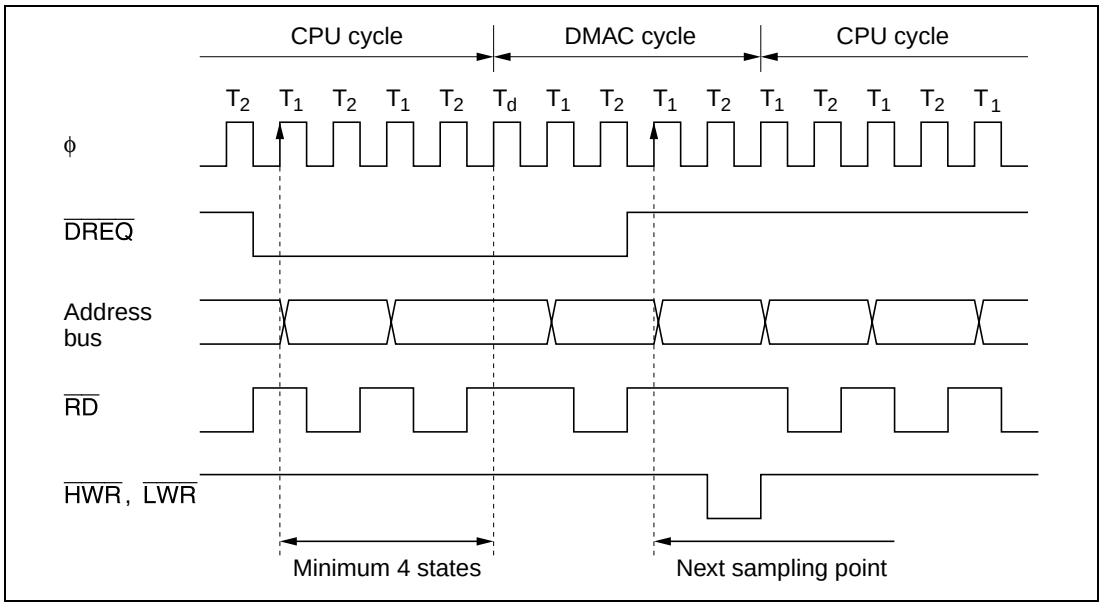


Figure 7.17 Timing of DMAC Activation by Low $\overline{\text{DREQ}}$ Level in Normal Mode

Figure 7.18 shows the timing when the DMAC is activated by the falling edge of $\overline{\text{DREQ}}$ in block transfer mode.

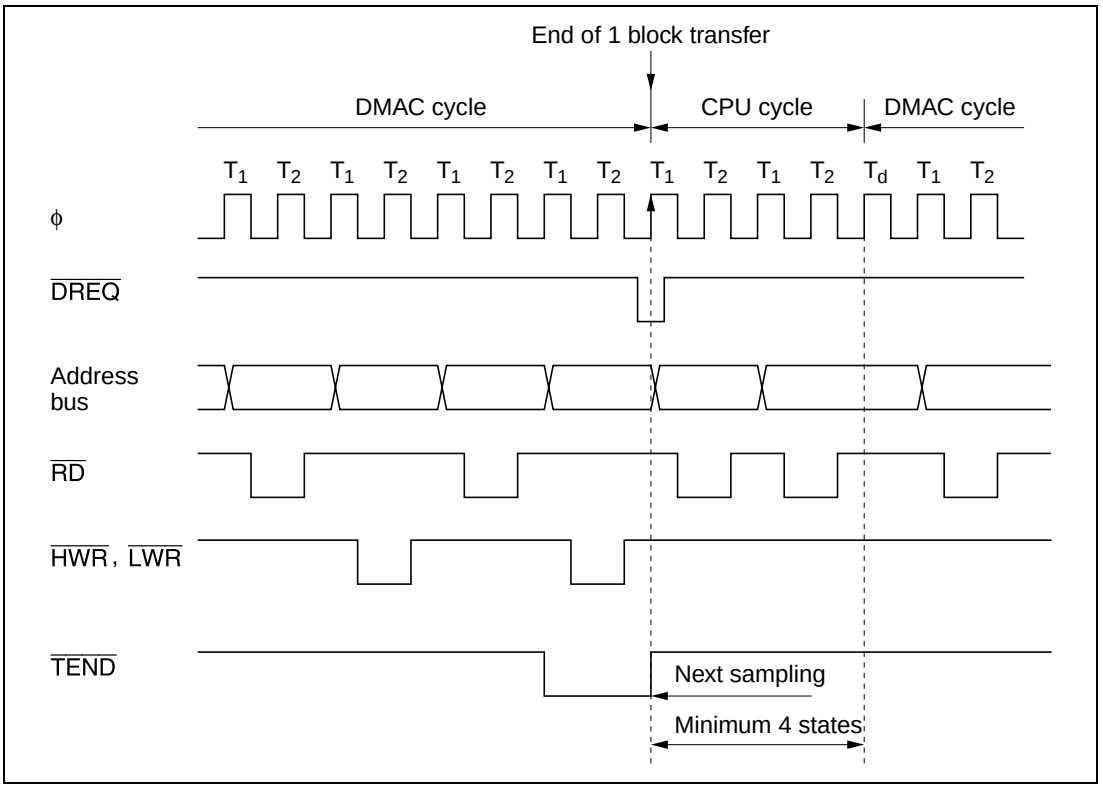


Figure 7.18 Timing of DMAC Activation by Falling Edge of $\overline{\text{DREQ}}$ in Block Transfer Mode

7.4.9 Multiple-Channel Operation

The DMAC channel priority order is: channel 0 > channel 1 and channel A > channel B.

Table 7.12 shows the complete priority order.

Table 7.12 Channel Priority Order

Short Address Mode	Full Address Mode	Priority
Channel 0A	Channel 0	High
Channel 0B		
Channel 1A	Channel 1	
Channel 1B		Low

If transfers are requested on two or more channels simultaneously, or if a transfer on one channel is requested during a transfer on another channel, the DMAC operates as follows.

- When a transfer is requested, the DMAC requests the bus right. When it gets the bus right, it starts a transfer on the highest-priority channel at that time.
- Once a transfer starts on one channel, requests to other channels are held pending until that channel releases the bus.
- After each transfer in short address mode, and each externally-requested or cycle-steal transfer in normal mode, the DMAC releases the bus and returns to step 1. After releasing the bus, if there is a transfer request for another channel, the DMAC requests the bus again.
- After completion of a burst-mode transfer, or after transfer of one block in block transfer mode, the DMAC releases the bus and returns to step 1. If there is a transfer request for a higher-priority channel or a bus request from a higher-priority bus master, however, the DMAC releases the bus after completing the transfer of the current byte or word. After releasing the bus, if there is a transfer request for another channel, the DMAC requests the bus again.

Figure 7.19 shows the timing when channel 0A is set up for I/O mode and channel 1 for burst mode, and a transfer request for channel 0A is received while channel 1 is active.

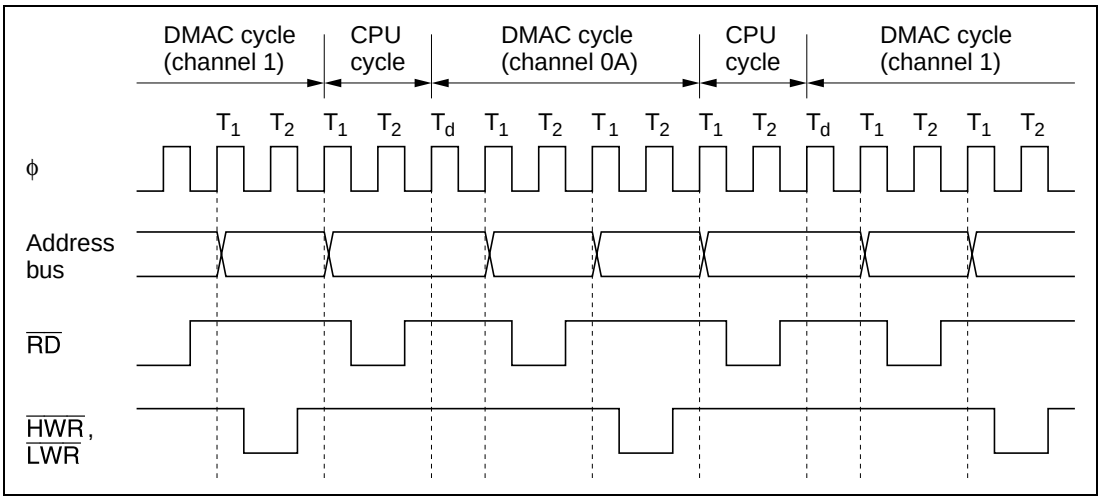


Figure 7.19 Timing of Multiple-Channel Operations

7.4.10 External Bus Requests, DRAM Interface, and DMAC

During a DMAC transfer, if the bus right is requested by an external bus request signal ($\overline{\text{BREQ}}$) or by the DRAM interface (refresh cycle), the DMAC releases the bus after completing the transfer of the current byte or word. If there is a transfer request at this point, the DMAC requests the bus right again. Figure 7.20 shows an example of the timing of insertion of a refresh cycle during a burst transfer on channel 0.

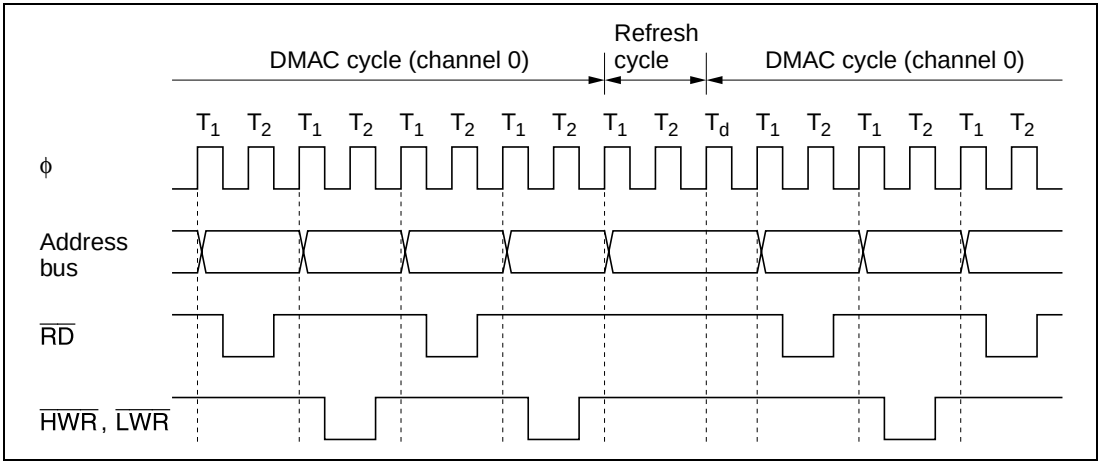


Figure 7.20 Bus Timing of DRAM Interface, and DMAC

7.4.11 NMI Interrupts and DMAC

NMI interrupts do not affect DMAC operations in short address mode.

If an NMI interrupt occurs during a transfer in full address mode, the DMAC suspends operations. In full address mode, a channel is enabled when its DTE and DTME bits are both set to 1. NMI input clears the DTME bit to 0. After transferring the current byte or word, the DMAC releases the bus to the CPU. In normal mode, the suspended transfer resumes when the CPU sets the DTME bit to 1 again. Check that the DTE bit is set to 1 and the DTME bit is cleared to 0 before setting the DTME bit to 1.

Figure 7.21 shows the procedure for resuming a DMAC transfer in normal mode on channel 0 after the transfer was halted by NMI input.

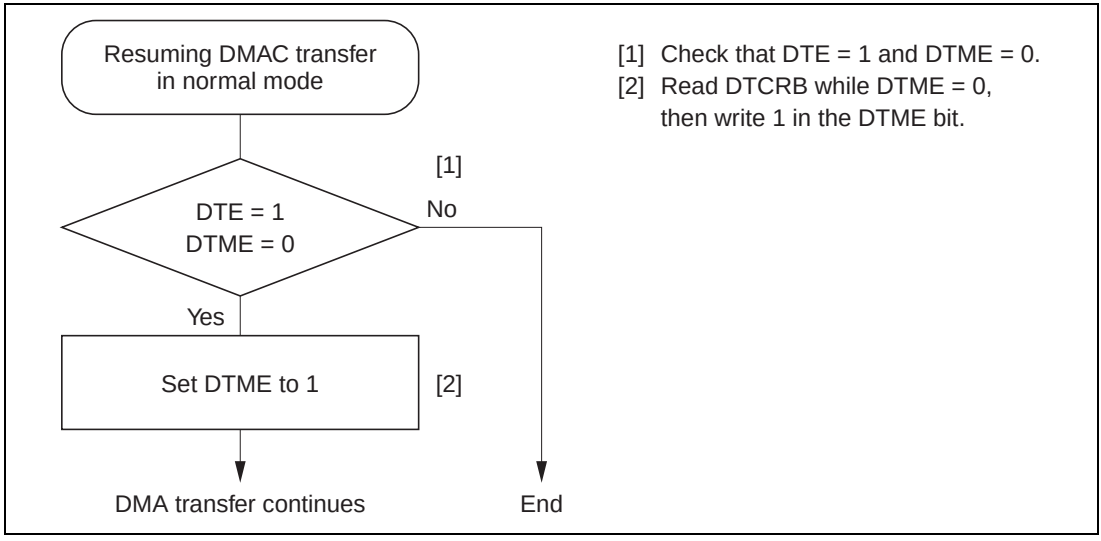


Figure 7.21 Procedure for Resuming a DMAC Transfer Halted by NMI (Example)

For information about NMI interrupts in block transfer mode, see section 7.6.6, NMI Interrupts and Block Transfer Mode.

7.4.12 Aborting a DMAC Transfer

When the DTE bit in an active channel is cleared to 0, the DMAC halts after transferring the current byte or word. The DMAC starts again when the DTE bit is set to 1. In full address mode, the DTME bit can be used for the same purpose. Figure 7.22 shows the procedure for aborting a DMAC transfer by software.

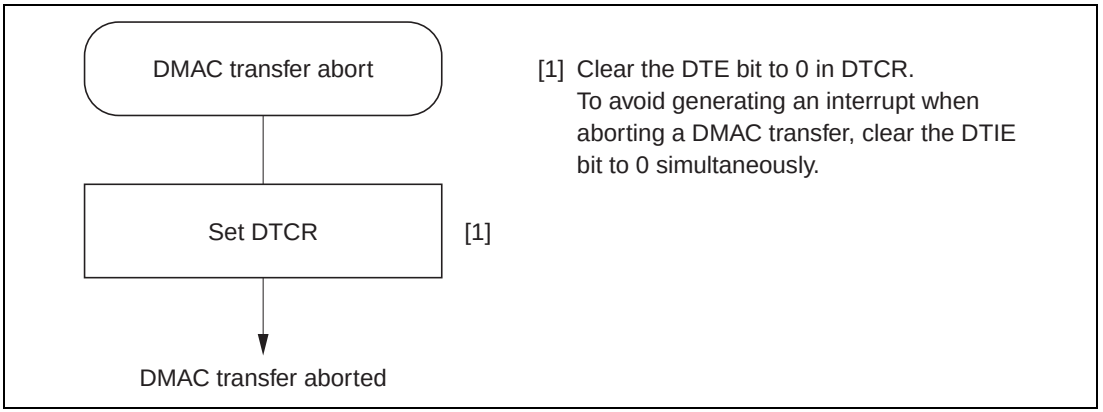


Figure 7.22 Procedure for Aborting a DMAC Transfer

7.4.13 Exiting Full Address Mode

Figure 7.23 shows the procedure for exiting full address mode and initializing the pair of channels. To set the channels up in another mode after exiting full address mode, follow the setup procedure for the relevant mode.

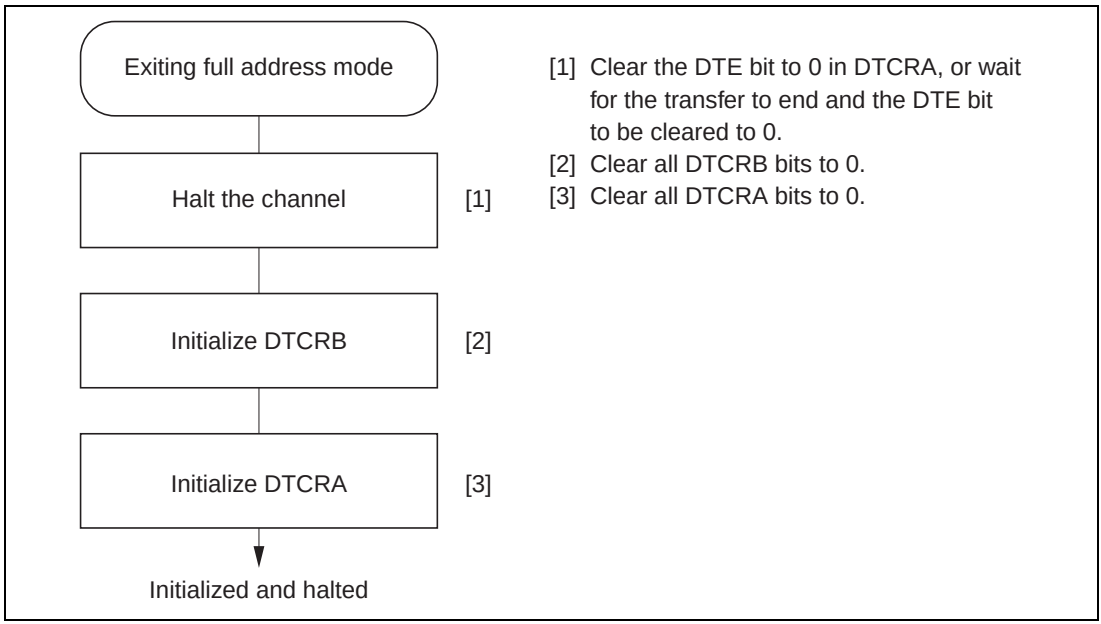


Figure 7.23 Procedure for Exiting Full Address Mode (Example)

7.4.14 DMAC States in Reset State, Standby Modes, and Sleep Mode

When the chip is reset or enters software standby mode, the DMAC is initialized and halts. DMAC operations continue in sleep mode. Figure 7.24 shows the timing of a cycle-steal transfer in sleep mode.

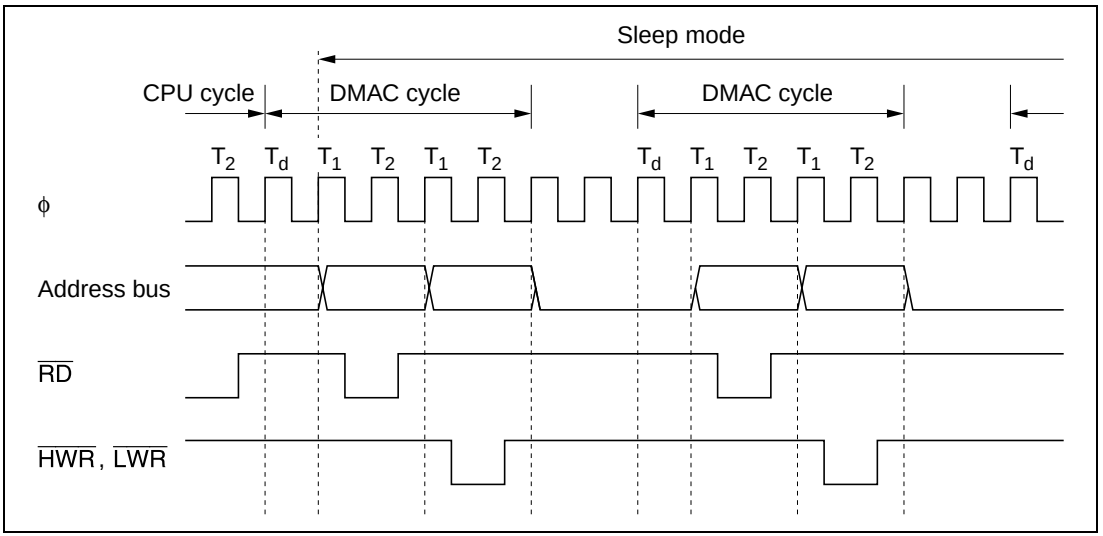


Figure 7.24 Timing of Cycle-Steal Transfer in Sleep Mode

7.5 Interrupts

The DMAC generates only DMA-end interrupts. Table 7.13 lists the interrupts and their priority.

Table 7.13 DMAC Interrupts

	Description		
Interrupt	**Short Address Mode**	**Full Address Mode**	**Interrupt Priority**
DEND0A	End of transfer on channel 0A	End of transfer on channel 0	High
DEND0B	End of transfer on channel 0B	—	
DEND1A	End of transfer on channel 1A	End of transfer on channel 1	
DEND1B	End of transfer on channel 1B	—	Low

Each interrupt is enabled or disabled by the DTIE bit in the corresponding data transfer control register (DTCR). Separate interrupt signals are sent to the interrupt controller.

The interrupt priority order among channels is channel 0 > channel 1 and channel A > channel B.

Figure 7.25 shows the DMA-end interrupt logic. An interrupt is requested whenever DTE = 0 and DTIE = 1.

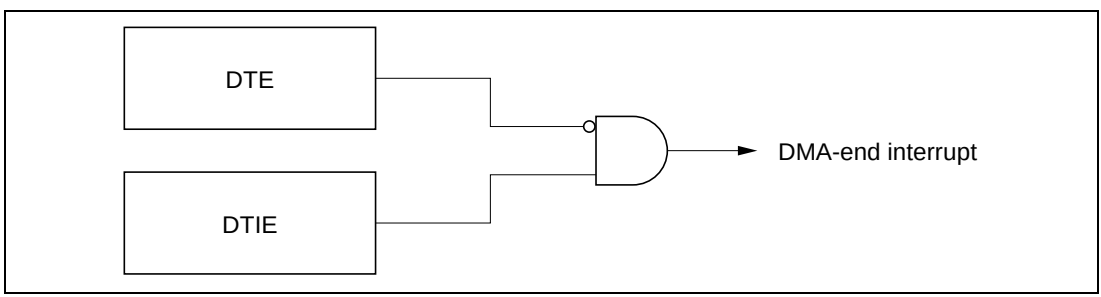


Figure 7.25 DMA-End Interrupt Logic

The DMA-end interrupt for the B channels (DENDB) is unavailable in full address mode. The DTME bit does not affect interrupt operations.

7.6 Usage Notes

7.6.1 Note on Word Data Transfer

Word data cannot be accessed starting at an odd address. When word-size transfer is selected, set even values in the memory and I/O address registers (MAR and IOAR).

7.6.2 DMAC Self-Access

The DMAC itself cannot be accessed during a DMAC cycle. DMAC registers cannot be specified as source or destination addresses.

7.6.3 Longword Access to Memory Address Registers

A memory address register can be accessed as longword data at the MARR address.

Example

```
MOV.L  #LBL, ER0
MOV.L  ER0, @MARR
```

Four byte accesses are performed. Note that the CPU may release the bus between the second byte (MARE) and third byte (MARH).

Memory address registers should be written and read only when the DMAC is halted.

7.6.4 Note on Full Address Mode Setup

Full address mode is controlled by two registers: DTCRA and DTCRB. Care must be taken to prevent the B channel from operating in short address mode during the register setup. The enable bits (DTE and DTME) should not be set to 1 until the end of the setup procedure.

7.6.5 Note on Activating DMAC by Internal Interrupts

When using an internal interrupt to activate the DMAC, make sure that the interrupt selected as the activating source does not occur during the interval after it has been selected but before the DMAC has been enabled. The on-chip supporting module that will generate the interrupt should not be activated until the DMAC has been enabled. If the DMAC must be enabled while the on-chip supporting module is active, follow the procedure in figure 7.26.

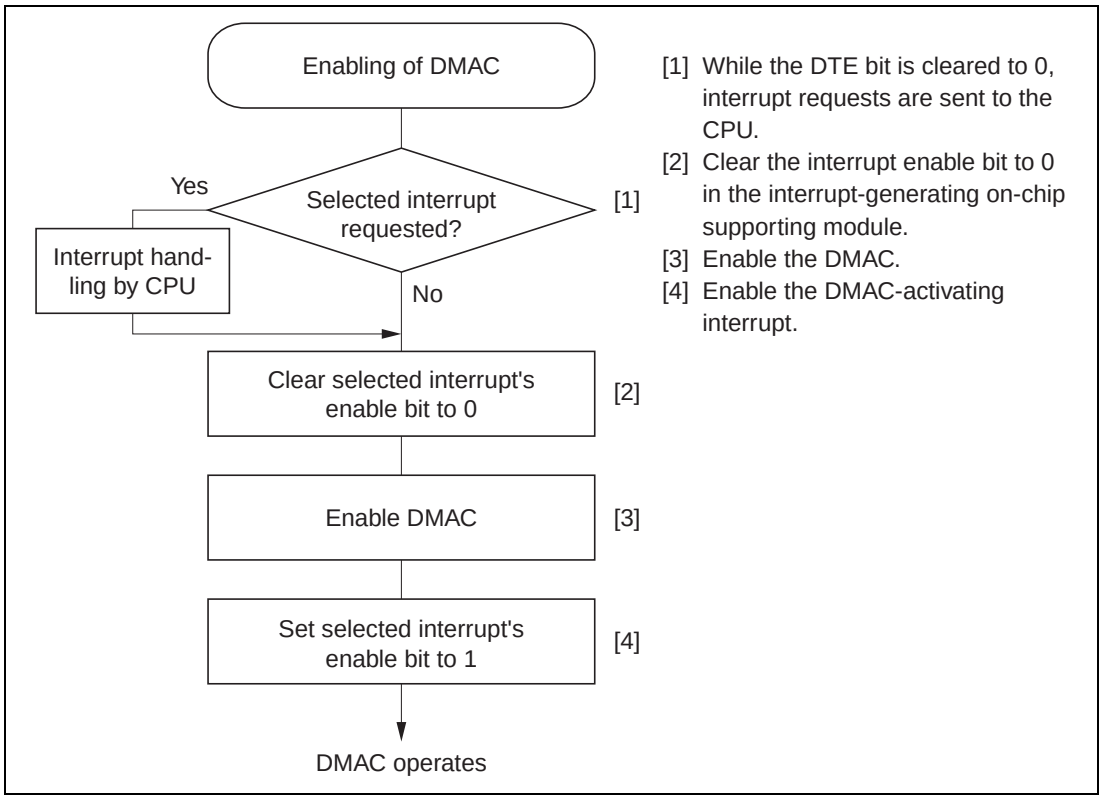


Figure 7.26 Procedure for Enabling DMAC while On-Chip Supporting Module is Operating (Example)

If the DTE bit is set to 1 but the DTME bit is cleared to 0, the DMAC is halted and the selected activating source cannot generate a CPU interrupt. If the DMAC is halted by an NMI interrupt, for example, the selected activating source cannot generate CPU interrupts. To terminate DMAC operations in this state, clear the DTE bit to 0 to allow CPU interrupts to be requested. To continue DMAC operations, carry out steps 2 and 4 in figure 7.26 before and after setting the DTME bit
to 1.

When 16-bit timer interrupt activates the DMAC, make sure the next interrupt does not occur before the DMA transfer ends. If one 16-bit timer interrupt activates two or more channels, make sure the next interrupt does not occur before the DMA transfers end on all the activated channels. If the next interrupt occurs before a transfer ends, the channel or channels for which that interrupt was selected may fail to accept further activation requests.

7.6.6 NMI Interrupts and Block Transfer Mode

If an NMI interrupt occurs in block transfer mode, the DMAC operates as follows.

- When the NMI interrupt occurs, the DMAC finishes transferring the current byte or word, then clears the DTME bit to 0 and halts. The halt may occur in the middle of a block.

  It is possible to find whether a transfer was halted in the middle of a block by checking the block size counter. If the block size counter does not have its initial value, the transfer was halted in the middle of a block.
- If the transfer is halted in the middle of a block, the activating interrupt flag is cleared to 0. The activation request is not held pending.
- While the DTE bit is set to 1 and the DTME bit is cleared to 0, the DMAC is halted and does not accept activating interrupt requests. If an activating interrupt occurs in this state, the DMAC does not operate and does not hold the transfer request pending internally. Neither is a CPU interrupt requested.

  For this reason, before setting the DTME bit to 1, first clear the enable bit of the activating interrupt to 0. Then, after setting the DTME bit to 1, set the interrupt enable bit to 1 again. See section 7.6.5, Note on Activating DMAC by Internal Interrupts.
- When the DTME bit is set to 1, the DMAC waits for the next transfer request. If it was halted in the middle of a block transfer, the rest of the block is transferred when the next transfer request occurs. Otherwise, the next block is transferred when the next transfer request occurs.

7.6.7 Memory and I/O Address Register Values

Table 7.14 indicates the address ranges that can be specified in the memory and I/O address registers (MAR and IOAR).

Table 7.14 Address Ranges Specifiable in MAR and IOAR

	1-Mbyte Mode	16-Mbyte Mode
MAR	H'00000 to H'FFFFF (0 to 1048575)	H'000000 to H'FFFFFF (0 to 16777215)
IOAR	H'FFF00 to H'FFFFF (1048320 to 1048575)	H'FFFF00 to H'FFFFFF (16776960 to 16777215)

MAR bits 23 to 20 are ignored in 1-Mbyte mode.

7.6.8 Bus Cycle when Transfer is Aborted

When a transfer is aborted by clearing the DTE bit or suspended by an NMI that clears the DTME bit, if this halts a channel for which the DMAC has a transfer request pending internally, a dead cycle may occur. This dead cycle does not update the halted channel's address register or counter value. Figure 7.27 shows an example in which an auto-requested transfer in cycle-steal mode on channel 0 is aborted by clearing the DTE bit in channel 0.

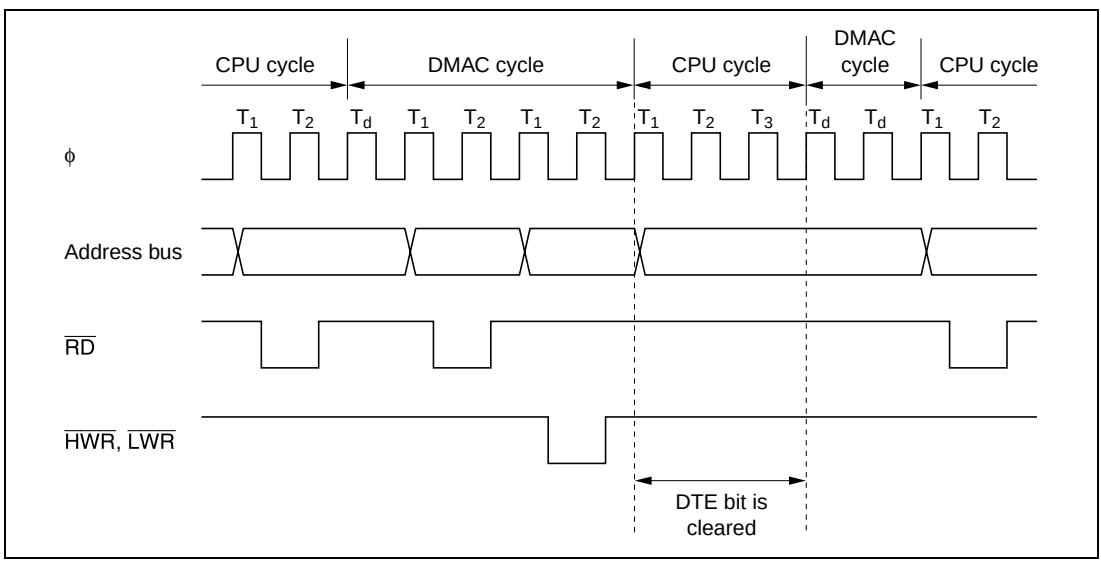


Figure 7.27 Bus Timing at Abort of DMA Transfer in Cycle-Steal Mode

7.6.9 Transfer Requests by A/D Converter

When the A/D converter is set to scan mode and conversion is performed on more than one channel, the A/D converter generates a transfer request when all conversions are completed. The converted data is stored in the appropriate ADDR registers. Block transfer mode and full address mode should therefore be used to transfer all the conversion results at one time.

Section 8 I/O Ports

8.1 Overview

This LSI has ten input/output ports (ports 1 to 6, 8, 9, A, and B) and one input port (port 7). Table 8.1 summarizes the port functions. The pins in each port are multiplexed as shown in table 8.1.

Each port has a data direction register (DDR) for selecting input or output, and a data register (DR) for storing output data. In addition to these registers, ports 2, 4, and 5 have an input pull-up control register (PCR) for switching input pull-up transistors on and off.

Ports 1 to 6 and port 8 can drive one TTL load and a 90-pF capacitive load. Ports 9, A, and B can drive one TTL load and a 30-pF capacitive load. Ports 1 to 6 and 8 to B can drive a darlington pair. Ports 1, 2, and 5 can drive LEDs (with 10-mA current sink). Pins $P8_2$ to $P8_0$, PA_7 to PA_0 have Schmitt-trigger input circuits.

For block diagrams of the ports see appendix C, I/O Port Block Diagrams.

Table 8.1 Port Functions

Port	Description	Pins	Expanded Modes					Single-Chip Modes
			Mode 1	Mode 2	Mode 3	Mode 4	Mode 5	Mode 7
Port 1	• 8-bit I/O port Can drive LEDs	$P1_7$ to $P1_0$/ A_7 to A_0	Address output pins (A_7 to A_0)				Address output (A_7 to A_0) and generic input DDR = 0: generic input DDR = 1: address output	Generic input/output
Port 2	• 8-bit I/O port Built-in input pull-up transistors Can drive LEDs	$P2_7$ to $P2_0$/ A_{15} to A_8	Address output pins (A_{15} to A_8)				Address output (A_{15} to A_8) and generic input DDR = 0: generic input DDR = 1: address output	Generic input/output
Port 3	• 8-bit I/O port	$P3_7$ to $P3_0$/ D_{15} to D_8	Data input/output (D_{15} to D_8)					Generic input/output
Port 4	• 8-bit I/O port • Built-in input pull-up transistors	$P4_7$ to $P4_0$/ D_7 to D_0	Data input/output (D_7 to D_0) and 8-bit generic input/output 8-bit bus mode: generic input/output 16-bit bus mode: data input/output					Generic input/output
Port 5	• 4-bit I/O port • Built-in input pull-up transistors • Can drive LEDs	$P5_3$ to $P5_0$/ A_{19} to A_{16}	Address output (A_{19} to A_{16})				Address output (A_{19} to A_{16}) and 4-bit generic input DDR = 0: generic input DDR = 1: address output	Generic input/output
Port 6	• 7-bit I/O port and 1-bit input port	$P6_7$/ϕ	Clock output (ϕ) and generic input					
		$P6_6$/$\overline{LWR}$ $P6_5$/$\overline{HWR}$ $P6_4$/$\overline{RD}$ $P6_3$/$\overline{AS}$	Bus control signal output ($\overline{LWR}$, $\overline{HWR}$, $\overline{RD}$, $\overline{AS}$)					Generic input/output
		$P6_2$/$\overline{BACK}$ $P6_1$/$\overline{BREQ}$ $P6_0$/$\overline{WAIT}$	Bus control signal input/output ($\overline{BACK}$, $\overline{BREQ}$, $\overline{WAIT}$) and 3-bit generic input/output					
Port 7	• 8-bit input port	$P7_7$/AN_7/DA_1 $P7_6$/AN_6/DA_0	Analog input (AN_7, AN_6) to A/D converter, analog output (DA_1, DA_0) from D/A converter, and generic input					
		$P7_5$ to $P7_0$/ AN_5 to AN_0	Analog input (AN_5 to AN_0) to A/D converter, and generic input					
Port 8	• 5-bit I/O port • $P8_2$ to $P8_0$ have Schmitt inputs	$P8_4$/$\overline{CS_0}$	DDR = 0: generic input DDR = 1 (reset value): $\overline{CS_0}$ output				DDR = 0 (reset value): generic input DDR = 1: $\overline{CS_0}$ output	Generic input/output
		$P8_3$/$\overline{IRQ_3}$/ $\overline{CS_1}$/$\overline{ADTRG}$	$\overline{IRQ_3}$ input, $\overline{CS_1}$ output, external trigger input ($\overline{ADTRG}$) to A/D converter, and generic input DDR = 0 (after reset): generic input DDR = 1: $\overline{CS_1}$ output					$\overline{IRQ_3}$ input, external trigger input ($\overline{ADTRG}$) to A/D converter, and generic input/output
		$P8_2$/$\overline{IRQ_2}$/$\overline{CS_2}$ $P8_1$/$\overline{IRQ_1}$/$\overline{CS_3}$	$\overline{IRQ_2}$ and $\overline{IRQ_1}$ input, $\overline{CS_2}$ and $\overline{CS_3}$ output, and generic input* DDR = 0 (reset value): generic input DDR = 1: $\overline{CS_2}$ and $\overline{CS_3}$ output					$\overline{IRQ_2}$ and $\overline{IRQ_1}$ input and generic input/output
		$P8_0$/$\overline{IRQ_0}$ /$\overline{RFSH}$	$\overline{IRQ_0}$ input, $\overline{RFSH}$ output, and generic input/output					$\overline{IRQ_0}$ input and generic input/output

Note: * $P8_1$ can be used as an output port by making a setting in DRCRA.

Port	Description	Pins	Expanded Modes					Single-Chip Modes
			Mode 1	Mode 2	Mode 3	Mode 4	Mode 5	Mode 7
Port 9	• 6-bit I/O port	$P9_6$/$\overline{IRQ_5}$ /SCK_1 $P9_5$/$\overline{IRQ_4}$ /SCK_0 $P9_3$/RxD_1 $P9_2$/RxD_0 $P9_1$/TxD_1 $P9_0$/TxD_0	Input and output (SCK_1, SCK_0, RxD_1, RxD_0, TxD_1, TxD_0) for serial communication interfaces 1 and 0 (SCI1/0), $\overline{IRQ_5}$ and $\overline{IRQ_4}$ input, and 6-bit generic input/output					
Port A	• 8-bit I/O port • Schmitt inputs	PA_7/TP_7/ $TIOCB_2$/A_{20}	Output (TP_7) from programmable timing pattern controller (TPC), input or output ($TIOCB_2$) for 16-bit timer and generic input/output		Address output (A_{20})		Address output (A_{20}), TPC output (TP_7), input or output ($TIOCB_2$) for 16-bit timer, and generic input/output	TPC output (TP_7), 16-bit timer input or output ($TIOCB_2$), and generic input/output
		PA_6/TP_6/ $TIOCA_2$/A_{21} PA_5/TP_5/ $TIOCB_1$/A_{22} PA_4/TP_4/ $TIOCA_1$/A_{23}	TPC output (TP_6 to TP_4), 16-bit timer input and output ($TIOCA_2$, $TIOCB_1$, $TIOCA_1$) , and generic input/output		TPC output (TP_6 to TP_4),16-bit timer input and output ($TIOCA_2$, $TIOCB_1$, $TIOCA_1$), address output (A_{23} to A_{21}), and generic input/output			TPC output (TP_6 to TP_4), 16-bit timer input and output ($TIOCA_2$, $TIOCB_1$, $TIOCA_1$) and generic input/output
		PA_3/TP_3/ $TIOCB_0$/ TCLKD PA_2/TP_2/ $TIOCA_0$/ TCLKC PA_1/TP_1/ TCLKB /$\overline{TEND_1}$ PA_0/TP_0/ TCLKA /$\overline{TEND_0}$	TPC output (TP_3 to TP_0), 16-bit timer input and output ($TIOCB_0$, $TIOCA_0$, TCLKD, TCLKC, TCLKB, TCLKA), 8-bit timer input (TCLKD, TCLKC, TCLKB, TCLKA), output ($\overline{TEND_1}$, $\overline{TEND_0}$) from DMA controller (DMAC), and generic input/output					
Port B	• 8-bit I/O port	PB_7/TP_{15}/ RXD_2 PB_6/TP_{14}/ TXD_2 PB_5/TP_{13}/ SCK_2/$\overline{LCAS}$ PB_4/TP_{12}/ $\overline{UCAS}$	TPC output (TP_{15} to TP_{12}), SCI2 input and output (SCK_2 , RxD_2, TxD_2), DRAM interface output ($\overline{LCAS}$, $\overline{UCAS}$), and generic input/output					TPC output (TP_{15} to TP_{12}), SCI2 input and output (SCK_2, RxD_2, TxD_2), and generic input/output
		PB_3/TP_{11}/ $TMIO_3$/ $\overline{DREQ_1}$/$\overline{CS_4}$ PB_2/TP_{10}/ TMO_2/$\overline{CS_5}$ PB_1/TP_9/ $TMIO_1$/ $\overline{DREQ_0}$/$\overline{CS_6}$ PB_0/TP_8/ TMO_0/$\overline{CS_7}$	TPC output (TP_{11} to TP_8), 8-bit timer input and output ($TMIO_3$, TMO_2, $TMIO_1$, TMO_0), DMAC input ($\overline{DREQ_1}$, $\overline{DREQ_0}$), $\overline{CS_7}$ to $\overline{CS_4}$ output, and generic input/output					TPC output (TP_{11} to TP_8), 8-bit timer input and output ($TMIO_3$, TMO_2, $TMIO_1$, TMO_0), DMAC input ($\overline{DREQ_1}$, $\overline{DREQ_0}$), and generic input/output

8.2 Port 1

8.2.1 Overview

Port 1 is an 8-bit input/output port also used for address output, with the pin configuration shown in figure 8.1. The pin functions differ between the expanded modes with on-chip ROM disabled, expanded modes with on-chip ROM enabled, and single-chip mode. In modes 1 to 4 (expanded modes with on-chip ROM disabled), they are address bus output pins (A_7 to A_0).

In mode 5 (expanded mode with on-chip ROM enabled), settings in the port 1 data direction register (P1DDR) can designate pins for address bus output (A_7 to A_0) or generic input. In mode 7 (single-chip mode), port 1 is a generic input/output port.

When DRAM is connected to areas 2 to 5, A_7 to A_0 output row and column addresses in read and write cycles. For details see section 6.5, DRAM Interface.

Pins in port 1 can drive one TTL load and a 90-pF capacitive load. They can also drive an LED or a darlington transistor pair.

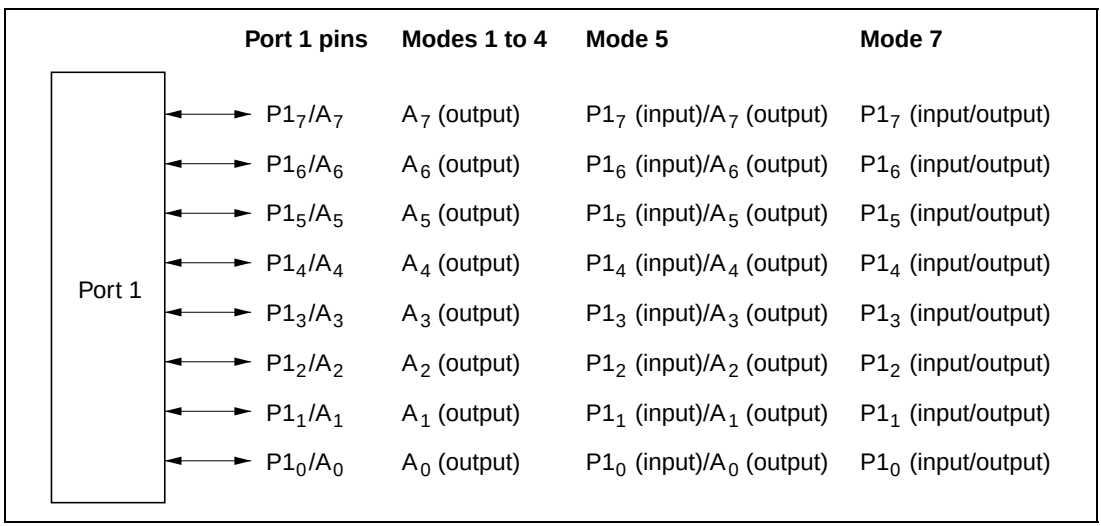


Figure 8.1 Port 1 Pin Configuration

8.2.2 Register Descriptions

Table 8.2 summarizes the registers of port 1.

Table 8.2 Port 1 Registers

Address*	Name	Abbreviation	R/W	Initial Value	
				Modes 1 to 4	Modes 5 and 7
H'EE000	Port 1 data direction register	P1DDR	W	H'FF	H'00
H'FFFD0	Port 1 data register	P1DR	R/W	H'00	H'00

Note: * Lower 20 bits of the address in advanced mode.

Port 1 Data Direction Register (P1DDR): P1DDR is an 8-bit write-only register that can select input or output for each pin in port 1.

Bit		7	6	5	4	3	2	1	0
		$P1_7DDR$	$P1_6DDR$	$P1_5DDR$	$P1_4DDR$	$P1_3DDR$	$P1_2DDR$	$P1_1DDR$	$P1_0DDR$
Modes 1 to 4	Initial value	1	1	1	1	1	1	1	1
	Read/Write	—	—	—	—	—	—	—	—
Modes 5 and 7	Initial value	0	0	0	0	0	0	0	0
	Read/Write	W	W	W	W	W	W	W	W

Port 1 data direction 7 to 0
These bits select input or output for port 1 pins

Modes 1 to 4 (Expanded Modes with On-Chip ROM Disabled): P1DDR values are fixed at 1. Port 1 functions as an address bus.

Mode 5 (Expanded Mode with On-Chip ROM Enabled): After a reset, port 1 functions as an input port. A pin in port 1 becomes an address output pin if the corresponding P1DDR bit is set to 1, and a generic input pin if this bit is cleared to 0.

Mode 7 (Single-Chip Mode): Port 1 functions as an input/output port. A pin in port 1 becomes an output port if the corresponding P1DDR bit is set to 1, and an input port if this bit is cleared to 0.

In modes 1 to 4, P1DDR bits are always read as 1, and cannot be modified.

In modes 5 and 7, P1DDR is a write-only register. Its value cannot be read. All bits return 1 when read.

P1DDR is initialized to H'FF in modes 1 to 4, and to H'00 in modes 5 and 7, by a reset and in hardware standby mode. In software standby mode it retains its previous setting. Therefore, if a transition is made to software standby mode while port 1 is functioning as an input/output port and a P1DDR bit is set to 1, the corresponding pin maintains its output state.

Port 1 Data Register (P1DR): P1DR is an 8-bit readable/writable register that stores port 1 output data. When port 1 functions as an output port, the value of this register is output. When this register is read, the pin logic level is read for bits for which the P1DDR setting is 0, and the P1DR value is read for bits for which the P1DDR setting is 1.

Bit	7	6	5	4	3	2	1	0
	$P1_7$	$P1_6$	$P1_5$	$P1_4$	$P1_3$	$P1_2$	$P1_1$	$P1_0$
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Port 1 data 7 to 0
These bits store data for port 1 pins

P1DR is initialized to H'00 by a reset and in hardware standby mode. In software standby mode it retains its previous setting.

8.3 Port 2

8.3.1 Overview

Port 2 is an 8-bit input/output port also used for address output, with the pin configuration shown in figure 8.2. The pin functions differ according to the operating mode.

In modes 1 to 4 (expanded modes with on-chip ROM disabled), port 2 consists of address bus output pins (A_{15} to A_8). In mode 5 (expanded mode with on-chip ROM enabled), settings in the port 2 data direction register (P2DDR) can designate pins for address bus output (A_{15} to A_8) or generic input. In mode 7 (single-chip mode), port 2 is a generic input/output port.

When DRAM is connected to areas 2 to 5, A_{12} to A_8 output row and column addresses in read and write cycles. For details see section 6.5, DRAM Interface.

Port 2 has software-programmable built-in pull-up transistors.

Pins in port 2 can drive one TTL load and a 90-pF capacitive load. They can also drive an LED or a darlington transistor pair.

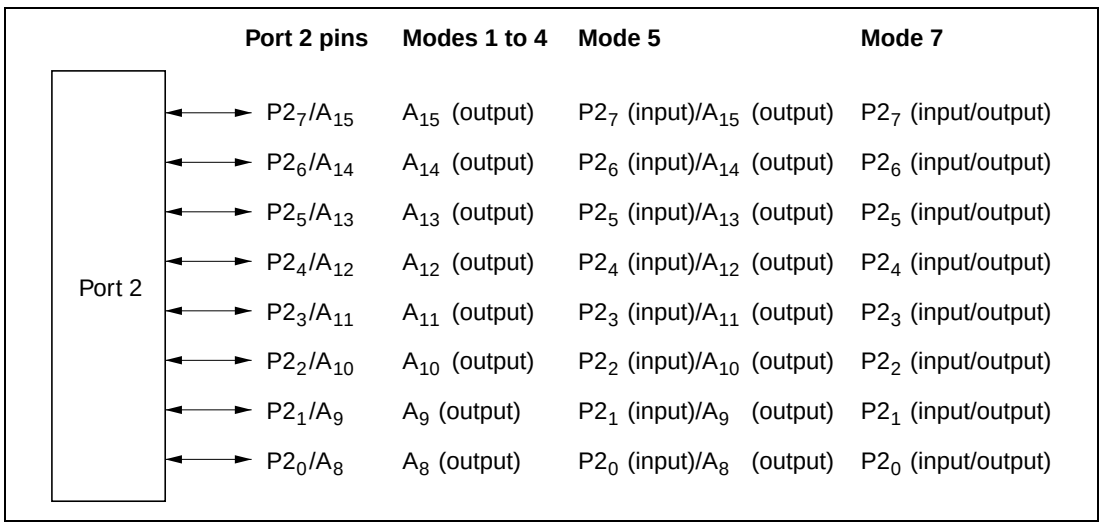


Figure 8.2 Port 2 Pin Configuration

8.3.2 Register Descriptions

Table 8.3 summarizes the registers of port 2.

Table 8.3 Port 2 Registers

Address*	Name	Abbreviation	R/W	Initial Value	
				Modes 1 to 4	Modes 5 and 7
H'EE001	Port 2 data direction register	P2DDR	W	H'FF	H'00
H'FFFD1	Port 2 data register	P2DR	R/W	H'00	H'00
H'EE03C	Port 2 input pull-up MOS control register	P2PCR	R/W	H'00	H'00

Note: * Lower 20 bits of the address in advanced mode.

Port 2 Data Direction Register (P2DDR): P2DDR is an 8-bit write-only register that can select input or output for each pin in port 2.

Bit		7	6	5	4	3	2	1	0
		$P2_7DDR$	$P2_6DDR$	$P2_5DDR$	$P2_4DDR$	$P2_3DDR$	$P2_2DDR$	$P2_1DDR$	$P2_0DDR$
Modes 1 to 4	Initial value	1	1	1	1	1	1	1	1
	Read/Write	—	—	—	—	—	—	—	—
Modes 5 and 7	Initial value	0	0	0	0	0	0	0	0
	Read/Write	W	W	W	W	W	W	W	W

Port 2 data direction 7 to 0
These bits select input or output for port 2 pins

Modes 1 to 4 (Expanded Modes with On-Chip ROM Disabled): P2DDR values are fixed at 1. Port 2 functions as an address bus.

Mode 5 (Expanded Mode with On-Chip ROM Enabled): Following a reset, port 2 is an input port. A pin in port 2 becomes an address output pin if the corresponding P2DDR bit is set to 1, and a generic input port if this bit is cleared to 0.

Mode 7 (Single-Chip Mode): Port 2 functions as an input/output port. A pin in port 2 becomes an output port if the corresponding P2DDR bit is set to 1, and an input port if this bit is cleared to 0.

In modes 1 to 4, P2DDR bits are always read as 1, and cannot be modified.

In modes 5 and 7, P2DDR is a write-only register. Its value cannot be read. All bits return 1 when read.

P2DDR is initialized to H'FF in modes 1 to 4, and to H'00 in modes 5 and 7, by a reset and in hardware standby mode. In software standby mode it retains its previous setting. Therefore, if a transition is made to software standby mode while port 2 is functioning as an input/output port and a P2DDR bit is set to 1, the corresponding pin maintains its output state.

Port 2 Data Register (P2DR): P2DR is an 8-bit readable/writable register that stores output data for port 2. When port 2 functions as an output port, the value of this register is output. When a bit in P2DDR is set to 1, if port 2 is read the value of the corresponding P2DR bit is returned. When a bit in P2DDR is cleared to 0, if port 2 is read the corresponding pin logic level is read.

Bit	7	6	5	4	3	2	1	0
	$P2_7$	$P2_6$	$P2_5$	$P2_4$	$P2_3$	$P2_2$	$P2_1$	$P2_0$
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Port 2 data 7 to 0
These bits store data for port 2 pins

P2DR is initialized to H'00 by a reset and in hardware standby mode. In software standby mode it retains its previous setting.

Port 2 Input Pull-Up MOS Control Register (P2PCR): P2PCR is an 8-bit readable/writable register that controls the MOS input pull-up transistors in port 2.

Bit	7	6	5	4	3	2	1	0
	$P2_7$PCR	$P2_6$PCR	$P2_5$PCR	$P2_4$PCR	$P2_3$PCR	$P2_2$PCR	$P2_1$PCR	$P2_0$PCR
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Port 2 input pull-up MOS control 7 to 0
These bits control input pull-up transistors built into port 2

In modes 5 and 7, when a P2DDR bit is cleared to 0 (selecting generic input), if the corresponding bit in P2PCR is set to 1, the input pull-up transistor is turned on.

P2PCR is initialized to H'00 by a reset and in hardware standby mode. In software standby mode it retains its previous setting.

Table 8.4 Input Pull-Up Transistor States (Port 2)

Mode	Reset	Hardware Standby Mode	Software Standby Mode	Other Modes
1 2 3 4	Off	Off	Off	Off
5 7	Off	Off	On/off	On/off

[Legend]

Off: The input pull-up transistor is always off.

On/off: The input pull-up transistor is on if P2PCR = 1 and P2DDR = 0. Otherwise, it is off.

8.4 Port 3

8.4.1 Overview

Port 3 is an 8-bit input/output port also used for data bus, with the pin configuration shown in figure 8.3. Port 3 is a data bus in modes 1 to 5 (expanded modes) and a generic input/output port in mode 7 (single-chip mode).

Pins in port 3 can drive one TTL load and a 90-pF capacitive load. They can also drive a darlington transistor pair.

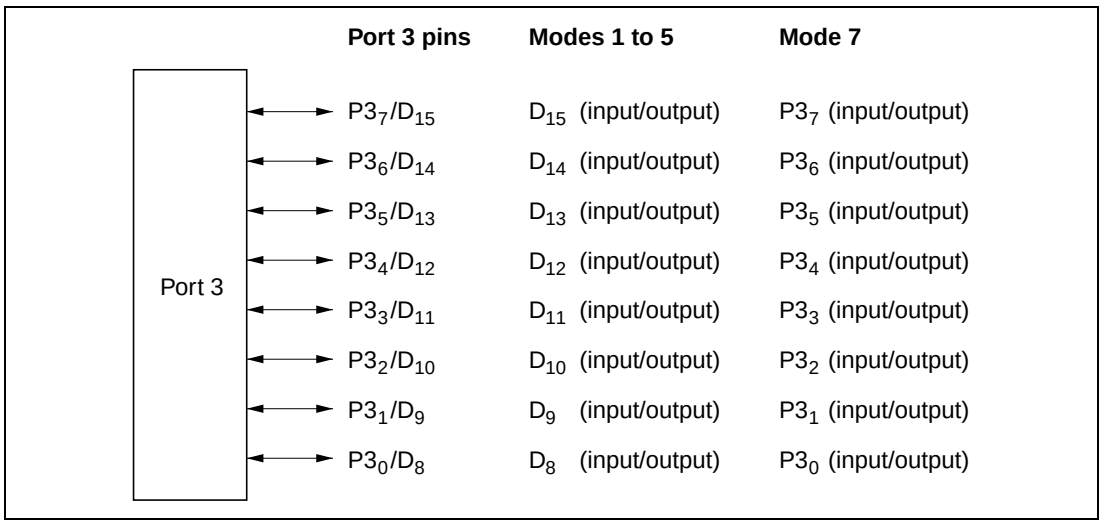


Figure 8.3 Port 3 Pin Configuration

8.4.2 Register Descriptions

Table 8.5 summarizes the registers of port 3.

Table 8.5 Port 3 Registers

Address*	Name	Abbreviation	R/W	Initial Value
H'EE002	Port 3 data direction register	P3DDR	W	H'00
H'FFFD2	Port 3 data register	P3DR	R/W	H'00

Note: * Lower 20 bits of the address in advanced mode.

Port 3 Data Direction Register (P3DDR): P3DDR is an 8-bit write-only register that can select input or output for each pin in port 3.

Bit	7	6	5	4	3	2	1	0
	$P3_7DDR$	$P3_6DDR$	$P3_5DDR$	$P3_4DDR$	$P3_3DDR$	$P3_2DDR$	$P3_1DDR$	$P3_0DDR$
Initial value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W

Port 3 data direction 7 to 0
These bits select input or output for port 3 pins

Modes 1 to 5 (Expanded Modes): Port 3 functions as a data bus, regardless of the P3DDR settings.

Mode 7 (Single-Chip Mode): Port 3 functions as an input/output port. A pin in port 3 becomes an output port if the corresponding P3DDR bit is set to 1, and an input port if this bit is cleared to 0.

P3DDR is a write-only register. Its value cannot be read. All bits return 1 when read.

P3DDR is initialized to H'00 by a reset and in hardware standby mode. In software standby mode it retains its previous setting. Therefore, if a transition is made to software standby mode while port 3 is functioning as an input/output port and a P3DDR bit is set to 1, the corresponding pin maintains its output state.

Port 3 Data Register (P3DR): P3DR is an 8-bit readable/writable register that stores output data for port 3. When port 3 functions as an output port, the value of this register is output. When a bit in P3DDR is set to 1, if port 3 is read the value of the corresponding P3DR bit is returned. When a bit in P3DDR is cleared to 0, if port 3 is read the corresponding pin logic level is read.

Bit	7	6	5	4	3	2	1	0
	$P3_7$	$P3_6$	$P3_5$	$P3_4$	$P3_3$	$P3_2$	$P3_1$	$P3_0$
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Port 3 data 7 to 0
These bits store data for port 3 pins

P3DR is initialized to H'00 by a reset and in hardware standby mode. In software standby mode it retains its previous setting.

8.5 Port 4

8.5.1 Overview

Port 4 is an 8-bit input/output port also used for data bus, with the pin configuration shown in figure 8.4. The pin functions differ depending on the operating mode.

In modes 1 to 5 (expanded modes), when the bus width control register (ABWCR) designates areas 0 to 7 all as 8-bit-access areas, the chip operates in 8-bit bus mode and port 4 is a generic input/output port. When at least one of areas 0 to 7 is designated as a 16-bit-access area, the chip operates in 16-bit bus mode and port 4 becomes part of the data bus. In mode 7 (single-chip mode), port 4 is a generic input/output port.

Port 4 has software-programmable built-in pull-up transistors.

Pins in port 4 can drive one TTL load and a 90-pF capacitive load. They can also drive a darlington transistor pair.

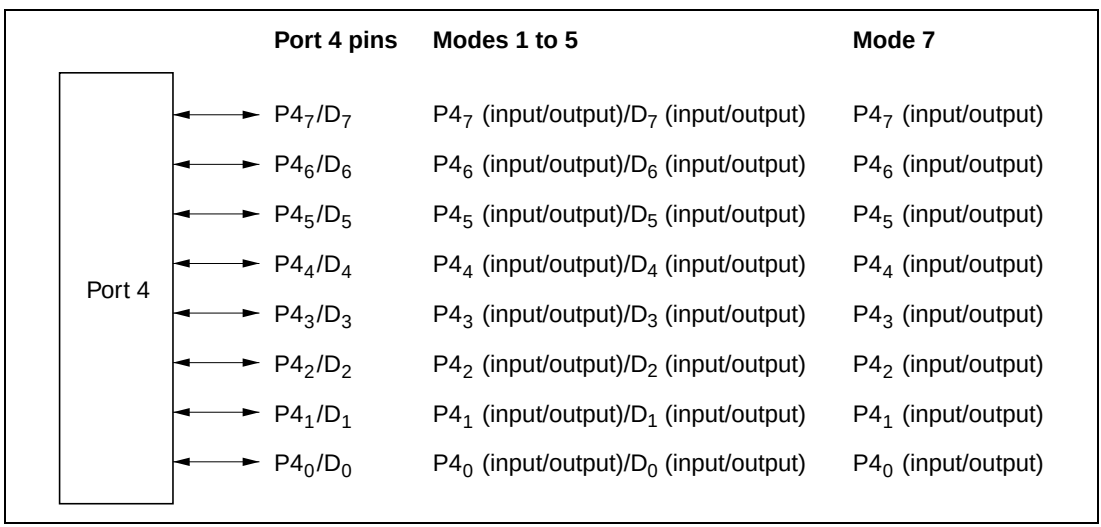


Figure 8.4 Port 4 Pin Configuration

8.5.2 Register Descriptions

Table 8.6 summarizes the registers of port 4.

Table 8.6 Port 4 Registers

Address*	Name	Abbreviation	R/W	Initial Value
H'EE003	Port 4 data direction register	P4DDR	W	H'00
H'FFFD3	Port 4 data register	P4DR	R/W	H'00
H'EE03E	Port 4 input pull-up control register	P4PCR	R/W	H'00

Note: * Lower 20 bits of the address in advanced mode.

Port 4 Data Direction Register (P4DDR): P4DDR is an 8-bit write-only register that can select input or output for each pin in port 4.

Bit	7	6	5	4	3	2	1	0
	$P4_7DDR$	$P4_6DDR$	$P4_5DDR$	$P4_4DDR$	$P4_3DDR$	$P4_2DDR$	$P4_1DDR$	$P4_0DDR$
Initial value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W

Port 4 data direction 7 to 0
These bits select input or output for port 4 pins

Modes 1 to 5 (Expanded Modes): When all areas are designated as 8-bit-access areas by the bus controller's bus width control register (ABWCR), selecting 8-bit bus mode, port 4 functions as an input/output port. In this case, a pin in port 4 becomes an output port if the corresponding P4DDR bit is set to 1, and an input port if this bit is cleared to 0.

When at least one area is designated as a 16-bit-access area, selecting 16-bit bus mode, port 4 functions as part of the data bus, regardless of the P4DDR settings.

Mode 7 (Single-Chip Mode): Port 4 functions as an input/output port. A pin in port 4 becomes an output port if the corresponding P4DDR bit is set to 1, and an input port if this bit is cleared to 0.

P4DDR is a write-only register. Its value cannot be read. All bits return 1 when read.

P4DDR is initialized to H'00 by a reset and in hardware standby mode. In software standby mode it retains its previous setting.

ABWCR and P4DDR are not initialized in software standby mode. Therefore, if a transition is made to software standby mode while port 4 is functioning as an input/output port and a P4DDR bit is set to 1, the corresponding pin maintains its output state.

Port 4 Data Register (P4DR): P4DR is an 8-bit readable/writable register that stores output data for port 4. When port 4 functions as an output port, the value of this register is output. When a bit in P4DDR is set to 1, if port 4 is read the value of the corresponding P4DR bit is returned. When a bit in P4DDR is cleared to 0, if port 4 is read the corresponding pin logic level is read.

Bit	7	6	5	4	3	2	1	0
	$P4_7$	$P4_6$	$P4_5$	$P4_4$	$P4_3$	$P4_2$	$P4_1$	$P4_0$
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Port 4 data 7 to 0
These bits store data for port 4 pins

P4DR is initialized to H'00 by a reset and in hardware standby mode. In software standby mode it retains its previous setting.

Port 4 Input Pull-Up MOS Control Register (P4PCR): P4PCR is an 8-bit readable/writable register that controls the MOS input pull-up transistors in port 4.

Bit	7	6	5	4	3	2	1	0
	$P4_7$PCR	$P4_6$PCR	$P4_5$PCR	$P4_4$PCR	$P4_3$PCR	$P4_2$PCR	$P4_1$PCR	$P4_0$PCR
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Port 4 input pull-up control 7 to 0
These bits control input pull-up transistors built into port 4

In mode 7 (single-chip mode), and in 8-bit bus mode in modes 1 to 5 (expanded modes), when a P4DDR bit is cleared to 0 (selecting generic input), if the corresponding P4PCR bit is set to 1, the input pull-up transistor is turned on.

P4PCR is initialized to H'00 by a reset and in hardware standby mode. In software standby mode it retains its previous setting.

Table 8.7 summarizes the states of the input pull-up transistors in each operating mode.

Table 8.7 Input Pull-Up Transistor States (Port 4)

Mode		Reset	Hardware Standby Mode	Software Standby Mode	Other Modes
1 to 5	8-bit bus mode	Off	Off	On/off	On/off
	16-bit bus mode			Off	Off
7				On/off	On/off

[Legend]

Off: The input pull-up transistor is always off.

On/off: The input pull-up transistor is on if P4PCR = 1 and P4DDR = 0. Otherwise, it is off.

8.6 Port 5

8.6.1 Overview

Port 5 is a 4-bit input/output port also used for address output, with the pin configuration shown in figure 8.5. The pin functions differ depending on the operating mode.

In modes 1 to 4 (expanded modes with on-chip ROM disabled), port 5 consists of address output pins (A_{19} to A_{16}). In mode 5 (expanded mode with on-chip ROM enabled), settings in the port 5 data direction register (P5DDR) designate pins for address bus output (A_{19} to A_{16}) or generic input. In mode 7 (single-chip mode), port 5 is a generic input/output port.

Port 5 has software-programmable built-in pull-up transistors.

Pins in port 5 can drive one TTL load and a 90-pF capacitive load. They can also drive an LED or a darlington transistor pair.

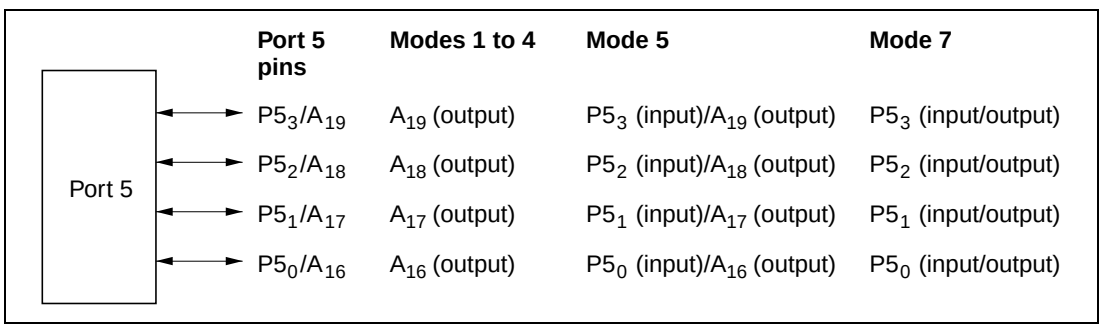


Figure 8.5 Port 5 Pin Configuration

8.6.2 Register Descriptions

Table 8.8 summarizes the registers of port 5.

Table 8.8 Port 5 Registers

				Initial Value	
Address*	**Name**	**Abbreviation**	**R/W**	**Modes 1 to 4**	**Modes 5 and 7**
H'EE004	Port 5 data direction register	P5DDR	W	H'FF	H'F0
H'FFFD4	Port 5 data register	P5DR	R/W	H'F0	H'F0
H'EE03F	Port 5 input pull-up control register	P5PCR	R/W	H'F0	H'F0

Note: * Lower 20 bits of the address in advanced mode.

Port 5 Data Direction Register (P5DDR): P5DDR is an 8-bit write-only register that can select input or output for each pin in port 5.

Bits 7 to 4 are reserved. They are fixed at 1, and cannot be modified.

Bit		7	6	5	4	3	2	1	0
		—	—	—	—	$P5_3DDR$	$P5_2DDR$	$P5_1DDR$	$P5_0DDR$
Modes 1 to 4	Initial value	1	1	1	1	1	1	1	1
	Read/Write	—	—	—	—	—	—	—	—
Modes 5 and 7	Initial value	1	1	1	1	0	0	0	0
	Read/Write	—	—	—	—	W	W	W	W

Reserved bits

Port 5 data direction 3 to 0
These bits select input or output for port 5 pins

Modes 1 to 4 (Expanded Modes with On-Chip ROM Disabled): P5DDR values are fixed at 1. Port 5 functions as an address bus.

Mode 5 (Expanded Mode with On-Chip ROM Enabled): Following a reset, port 5 is an input port. A pin in port 5 becomes an address output pin if the corresponding P5DDR bit is set to 1, and an input port if this bit is cleared to 0.

Mode 7 (Single-Chip Mode): Port 5 functions as an input/output port. A pin in port 5 becomes an output port if the corresponding P5DDR bit is set to 1, and an input port if this bit is cleared to 0.

In modes 1 to 4, P5DDR bits are always read as 1, and cannot be modified.

In modes 5 and 7, P5DDR is a write-only register. Its value cannot be read. All bits return 1 when read.

P5DDR is initialized to H'FF in modes 1 to 4, and to H'F0 in modes 5 and 7, by a reset and in hardware standby mode. In software standby mode it retains its previous setting. Therefore, if a transition is made to software standby mode while port 5 is functioning as an input/output port and a P5DDR bit is set to 1, the corresponding pin maintains its output state.

Port 5 Data Register (P5DR): P5DR is an 8-bit readable/writable register that stores output data for port 5. When port 5 functions as an output port, the value of this register is output. When a bit in P5DDR is set to 1, if port 5 is read the value of the corresponding P5DR bit is returned. When a bit in P5DDR is cleared to 0, if port 5 is read the corresponding pin logic level is read.

Bits 7 to 4 are reserved. They are fixed at 1, and cannot be modified.

Bit	7	6	5	4	3	2	1	0
	—	—	—	—	$P5_3$	$P5_2$	$P5_1$	$P5_0$
Initial value	1	1	1	1	0	0	0	0
Read/Write	—	—	—	—	R/W	R/W	R/W	R/W

Reserved bits

Port 5 data 3 to 0
These bits store data for port 5 pins

P5DR is initialized to H'F0 by a reset and in hardware standby mode. In software standby mode it retains its previous setting.

Port 5 Input Pull-Up MOS Control Register (P5PCR): P5PCR is an 8-bit readable/writable register that controls the MOS input pull-up transistors in port 5.

Bits 7 to 4 are reserved. They are fixed at 1, and cannot be modified.

Bit	7	6	5	4	3	2	1	0
	—	—	—	—	$P5_3PCR$	$P5_2PCR$	$P5_1PCR$	$P5_0PCR$
Initial value	1	1	1	1	0	0	0	0
Read/Write	—	—	—	—	R/W	R/W	R/W	R/W

Reserved bits

Port 5 input pull-up control 3 to 0
These bits control input pull-up transistors built into port 5

In modes 5 and 7, when a P5DDR bit is cleared to 0 (selecting generic input), if the corresponding bit in P5PCR is set to 1, the input pull-up transistor is turned on.

P5PCR is initialized to H'F0 by a reset and in hardware standby mode. In software standby mode it retains its previous setting.

Table 8.9 summarizes the states of the input pull-ups in each mode.

Table 8.9 Input Pull-Up Transistor States (Port 5)

Mode	Reset	Hardware Standby Mode	Software Standby Mode	Other Modes
1 2 3 4	Off	Off	Off	Off
5 7	Off	Off	On/off	On/off

[Legend]

Off: The input pull-up transistor is always off.

On/off: The input pull-up transistor is on if P5PCR = 1 and P5DDR = 0. Otherwise, it is off.

8.7 Port 6

8.7.1 Overview

Port 6 is an 8-bit input/output port that is also used for input and output of bus control signals ($\overline{LWR}$, $\overline{HWR}$, $\overline{RD}$, $\overline{AS}$, $\overline{BACK}$, $\overline{BREQ}$, $\overline{WAIT}$) and for clock (ϕ) output.

The pin configuration of port 6 is shown in figure 8.6.

In modes 1 to 5 (expanded modes), the pin functions are $P6_7$ (generic input)/ϕ, $\overline{LWR}$, $\overline{HWR}$, $\overline{RD}$, $\overline{AS}$, $P6_2$/$\overline{BACK}$, $P6_1$/$\overline{BREQ}$, and $P6_0$/$\overline{WAIT}$). See table 8.11 for the selection of the pin functions. In mode 7 (single-chip mode), $P6_7$ functions as a generic input port or ø output, and $P6_6$ to $P6_0$ function as generic input/output ports.

When DRAM is connected to areas 2 to 5, $\overline{LWR}$, $\overline{HWR}$, and $\overline{RD}$ also function as $\overline{LCAS}$, $\overline{UCAS}$, and $\overline{WE}$, respectively. For details see section 6.5, DRAM Interface.

Pins in port 6 can drive one TTL load and a 90-pF capacitive load. They can also drive a darlington transistor pair.

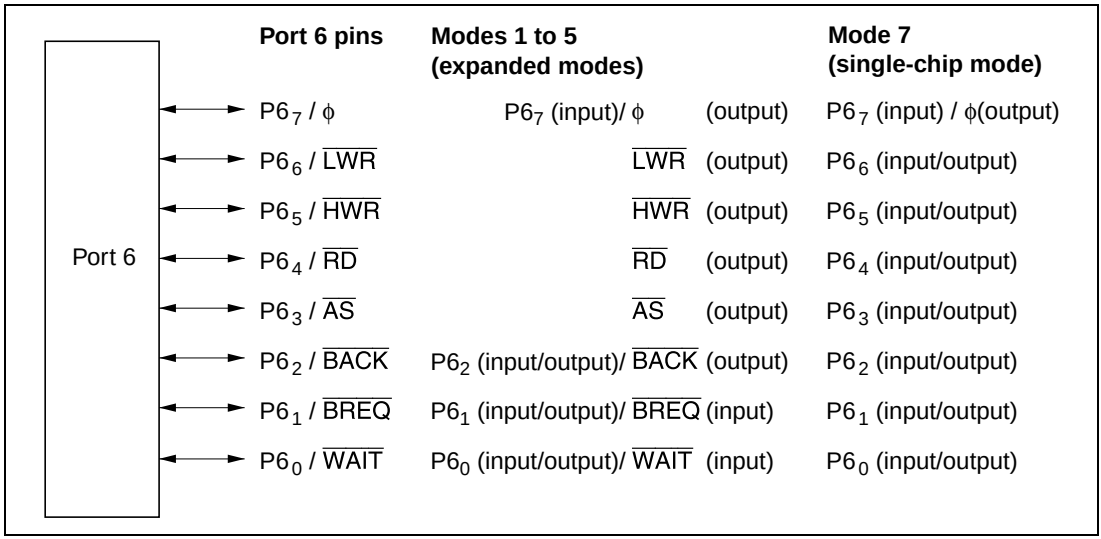


Figure 8.6 Port 6 Pin Configuration

8.7.2 Register Descriptions

Table 8.10 summarizes the registers of port 6.

Table 8.10 Port 6 Registers

Address*	Name	Abbreviation	R/W	Initial Value
H'EE005	Port 6 data direction register	P6DDR	W	H'80
H'FFFD5	Port 6 data register	P6DR	R/W	H'80

Note: * Lower 20 bits of the address in advanced mode.

Port 6 Data Direction Register (P6DDR): P6DDR is an 8-bit write-only register that can select input or output for each pin in port 6.

Bit 7 is reserved. It is fixed at 1, and cannot be modified.

Bit	7	6	5	4	3	2	1	0
	—	$P6_6DDR$	$P6_5DDR$	$P6_4DDR$	$P6_3DDR$	$P6_2DDR$	$P6_1DDR$	$P6_0DDR$
Initial value	1	0	0	0	0	0	0	0
Read/Write	—	W	W	W	W	W	W	W

Reserved bit

Port 6 data direction 6 to 0
These bits select input or output for port 6 pins

Modes 1 to 5 (Expanded Modes): $P6_7$ functions as the clock output pin (ϕ) or an input port. $P6_7$ is the clock output pin (ϕ) if the PSTOP bit in MSTRCH is cleared to 0 (initial value), and an input port if this bit is set to 1.

$P6_6$ to $P6_3$ function as bus control output pins ($\overline{LWR}$, $\overline{HWR}$, $\overline{RD}$, and $\overline{AS}$), regardless of the settings of bits $P6_6DDR$ to $P6_3DDR$.

$P6_2$ to $P6_0$ function as bus control input/output pins ($\overline{BACK}$, $\overline{BREQ}$, and $\overline{WAIT}$) or input/output ports. For the method of selecting the pin functions, see table 8.11.

When $P6_2$ to $P6_0$ function as input/output ports, the pin becomes an output port if the corresponding P6DDR bit is set to 1, and an input port if this bit is cleared to 0.

Mode 7 (Single-Chip Mode): $P6_7$ functions as the clock output pin (ϕ) or an input port. $P6_6$ to $P6_0$ function as generic input/output ports. $P6_7$ is the clock output pin (ϕ) if the PSTOP bit in MSTCRH is cleared to 0, and an input port if this bit is set to 1 (initial value). A pin in port 6 becomes an output port if the corresponding bit of $P6_6DDR$ to $P6_0DDR$ is set to 1, and an input port if this pin is cleared to 0.

P6DDR is a write-only register. Its value cannot be read. All bits return 1 when read.

P6DDR is initialized to H'80 by a reset and in hardware standby mode. In software standby mode it retains its previous setting. Therefore, if a transition is made to software standby mode while port 6 is functioning as an input/output port and a P6DDR bit is set to 1, the corresponding pin maintains its output state.

Port 6 Data Register (P6DR): P6DR is an 8-bit readable/writable register that stores output data for port 6. When port 6 functions as an output port, the value of this register is output. For bit 7, a value of 1 is returned if the bit is read while the PSTOP bit in MSTCRH is cleared to 0, and the $P6_7$ pin logic level is returned if the bit is read while the PSTOP bit is set to 1. Bit 7 cannot be modified. For bits 6 to 0, the pin logic level is returned if the bit is read while the corresponding bit in P6DDR is cleared to 0, and the P6DR value is returned if the bit is read while the corresponding bit in P6DDR is set to 1.

Bit	7	6	5	4	3	2	1	0
	$P6_7$	$P6_6$	$P6_5$	$P6_4$	$P6_3$	$P6_2$	$P6_1$	$P6_0$
Initial value	1	0	0	0	0	0	0	0
Read/Write	R	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Port 6 data 7 to 0
These bits store data for port 6 pins

P6DR is initialized to H'80 by a reset and in hardware standby mode. In software standby mode it retains its previous setting.

Table 8.11 Port 6 Pin Functions in Modes 1 to 5

Pin	Pin Functions and Selection Method		
$P6_7/\phi$	Bit PSTOP in MSTCRH selects the pin function.		
	PSTOP	0	1
	Pin function	ϕ output	$P6_7$ input
$\overline{LWR}$	Functions as $\overline{LWR}$ regardless of the setting of bit $P6_6DDR$.		
	$P6_6DDR$	0	1
	Pin function	$\overline{LWR}$ output*	
	Note: * If any of bits DRAS2 to DRAS0 in DRCRA is 1 and bit CSEL in DRCRB is 1, $\overline{LWR}$ output functions as $\overline{LCAS}$.		
$\overline{HWR}$	Functions as $\overline{HWR}$ regardless of the setting of bit $P6_5DDR$.		
	$P6_5DDR$	0	1
	Pin function	$\overline{HWR}$ output*	
	Note: * If any of bits DRAS2 to DRAS0 in DRCRA is 1 and bit CSEL in DRCRB is 1, $\overline{HWR}$ output functions as $\overline{UCAS}$.		
$\overline{RD}$	Functions as $\overline{RD}$ regardless of the setting of bit $P6_4DDR$.		
	$P6_4DDR$	0	1
	Pin function	$\overline{RD}$ output*	
	Note: * If any of bits DRAS2 to DRAS0 in DRCRA is 1, $\overline{RD}$ output functions as $\overline{WE}$.		
$\overline{AS}$	Functions as $\overline{AS}$ regardless of the setting of bit $P6_3DDR$.		
	$P6_3DDR$	0	1
	Pin function	$\overline{AS}$ output	
$P6_2/\overline{BACK}$	Bit BRLE in BRCR and bit $P6_2DDR$ select the pin function as follows.		
	BRLE	0	1
	$P6_2DDR$	0	1	—
	Pin function	$P6_2$ input	$P6_2$ output	$\overline{BACK}$ output
$P6_1/\overline{BREQ}$	Bit BRLE in BRCR and bit $P6_1DDR$ select the pin function as follows.		
	BRLE	0	1
	$P6_1DDR$	0	1	—
	Pin function	$P6_1$ input	$P6_1$ output	$\overline{BREQ}$ input
$P6_0/\overline{WAIT}$	Bit WAITE in BCR and bit $P6_0DDR$ select the pin function as follows.		
	WAITE	0	1
	$P6_0DDR$	0	1	0*
	Pin function	$P6_0$ input	$P6_0$ output	$\overline{WAIT}$ input
	Note: * Do not set bit $P6_0DDR$ to 1.		

8.8 Port 7

8.8.1 Overview

Port 7 is an 8-bit input port that is also used for analog input to the A/D converter and analog output from the D/A converter. The pin functions are the same in all operating modes. Figure 8.7 shows the pin configuration of port 7.

See section 15, A/D Converter, for details of the A/D converter analog input pins, and section 16, D/A Converter, for details of the D/A converter analog output pins.

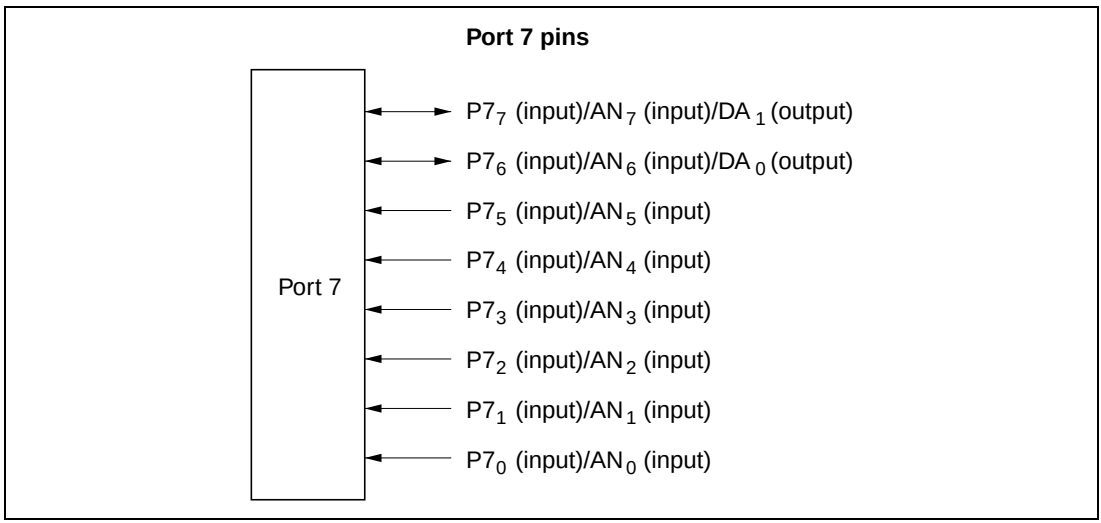


Figure 8.7 Port 7 Pin Configuration

8.8.2 Register Description

Table 8.12 summarizes the port 7 register. Port 7 is an input port, and port 7 has no data direction register.

Table 8.12 Port 7 Data Register

Address*	Name	Abbreviation	R/W	Initial Value
H'FFFD6	Port 7 data register	P7DR	R	Undetermined

Note: * Lower 20 bits of the address in advanced mode.

Port 7 Data Register (P7DR)

Bit	7	6	5	4	3	2	1	0
	$P7_7$	$P7_6$	$P7_5$	$P7_4$	$P7_3$	$P7_2$	$P7_1$	$P7_0$
Initial value	—*	—*	—*	—*	—*	—*	—*	—*
Read/Write	R	R	R	R	R	R	R	R

Note: * Determined by pins $P7_7$ to $P7_0$.

When port 7 is read, the pin logic levels are always read. P7DR cannot be modified.

8.9 Port 8

8.9.1 Overview

Port 8 is a 5-bit input/output port that is also used for $\overline{CS}_3$ to $\overline{CS}_0$ output, $\overline{RFSH}$ output, $\overline{IRQ}_3$ to $\overline{IRQ}_0$ input, and A/D converter $\overline{ADTRG}$ input. Figure 8.8 shows the pin configuration of port 8.

In modes 1 to 5 (expanded modes), port 8 can provide $\overline{CS}_3$ to $\overline{CS}_0$ output, $\overline{RFSH}$ output, $\overline{IRQ}_3$ to $\overline{IRQ}_0$ input, and $\overline{ADTRG}$ input. See table 8.14 for the selection of pin functions in expanded modes.

In mode 7 (single-chip mode), port 8 can provide $\overline{IRQ}_3$ to $\overline{IRQ}_0$ input and $\overline{ADTRG}$ input. See table 8.15 for the selection of pin functions in single-chip mode.

See section 15, A/D Converter, for a description of the A/D converter's $\overline{ADTRG}$ input pin.

The $\overline{IRQ}_3$ to $\overline{IRQ}_0$ functions are selected by IER settings, regardless of whether the pin is used for input or output. Caution is therefore required. For details see section 5.3.1, External Interrupts.

When DRAM is connected to areas 2 to 5, the $\overline{CS}_3$ and $\overline{CS}_2$ output pins function as $\overline{RAS}$ output pins for each area. For details see section 6.5, DRAM Interface.

Pins in port 8 can drive one TTL load and a 90-pF capacitive load. They can also drive a darlington transistor pair.

Pins $P8_2$ to $P8_0$ have Schmitt-trigger inputs.

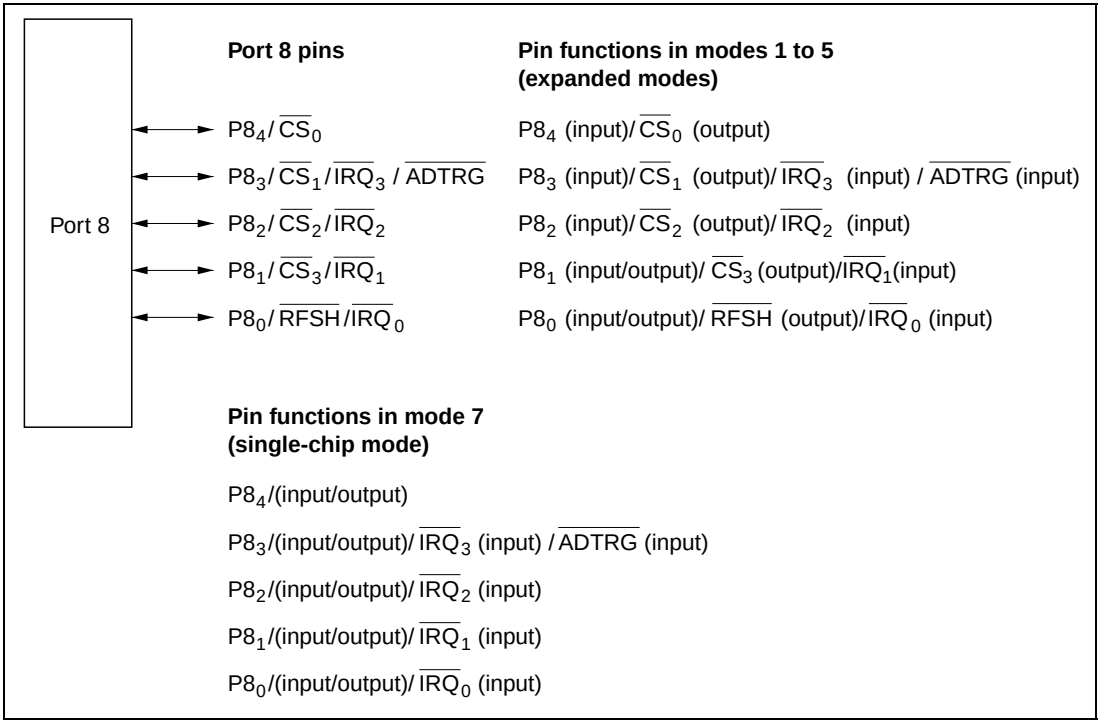


Figure 8.8 Port 8 Pin Configuration

8.9.2 Register Descriptions

Table 8.13 summarizes the registers of port 8.

Table 8.13 Port 8 Registers

Address*	Name	Abbreviation	R/W	Initial Value	
				Modes 1 to 4	Modes 5 and 7
H'EE007	Port 8 data direction register	P8DDR	W	H'F0	H'E0
H'FFFD7	Port 8 data register	P8DR	R/W	H'E0	H'E0

Note: * Lower 20 bits of the address in advanced mode.

Port 8 Data Direction Register (P8DDR): P8DDR is an 8-bit write-only register that can select input or output for each pin in port 8.

Bits 7 to 5 are reserved. They are fixed at 1, and cannot be modified.

Bit		7	6	5	4	3	2	1	0
		—	—	—	$P8_4DDR$	$P8_3DDR$	$P8_2DDR$	$P8_1DDR$	$P8_0DDR$
Modes 1 to 4	Initial value	1	1	1	1	0	0	0	0
	Read/Write	—	—	—	W	W	W	W	W
Modes 5 and 7	Initial value	1	1	1	0	0	0	0	0
	Read/Write	—	—	—	W	W	W	W	W

Reserved bits

Port 8 data direction 4 to 0
These bits select input or output for port 8 pins

Modes 1 to 5 (Expanded Modes): When bits in P8DDR bit are set to 1, $P8_4$ to $P8_1$ become $\overline{CS}_0$ to $\overline{CS}_3$ output pins. When bits in P8DDR are cleared to 0, the corresponding pins become input ports. However, $P8_1$ can also be used as an output port, depending on the setting of bits DRAS2 to DRAS0 in DRAM control register A (DRCRA). For details see section 6.5.2, DRAM Space and $\overline{RAS}$ Output Pin Settings.

In modes 1 to 4 (expanded modes with on-chip ROM disabled), following a reset $P8_4$ functions as the $\overline{CS}_0$ output, while $\overline{CS}_1$ to $\overline{CS}_3$ are input ports. In mode 5 (expanded mode with on-chip ROM enabled), following a reset $\overline{CS}_0$ to $\overline{CS}_3$ are all input ports.

When the refresh enable bit (RFSHE) in DRCRA is set to 1, $P8_0$ is used for $\overline{RFSH}$ output. When RFSHE is cleared to 0, $P8_0$ becomes an input/output port according to the P8DDR setting. For details see table 8.14.

Mode 7 (Single-Chip Mode): Port 8 is a generic input/output port. A pin in port 8 becomes an output port if the corresponding P8DDR bit is set to 1, and an input port if this bit is cleared to 0.

P8DDR is a write-only register. Its value cannot be read. All bits return 1 when read.

P8DDR is initialized to H'F0 in modes 1 to 4, and to H'E0 in modes 5 and 7, by a reset and in hardware standby mode. In software standby mode P8DDR retains its previous setting. Therefore, if a transition is made to software standby mode while port 8 is functioning as an input/output port and a P8DDR bit is set to 1, the corresponding pin maintains its output state.

Port 8 Data Register (P8DR): P8DR is an 8-bit readable/writable register that stores output data for port 8. When port 8 functions as an output port, the value of this register is output. When a bit in P8DDR is set to 1, if port 8 is read the value of the corresponding P8DR bit is returned. When a bit in P8DDR is cleared to 0, if port 8 is read the corresponding pin logic level is read.

Bits 7 to 5 are reserved. They are fixed at 1, and cannot be modified.

Bit	7	6	5	4	3	2	1	0
	—	—	—	$P8_4$	$P8_3$	$P8_2$	$P8_1$	$P8_0$
Initial value	1	1	1	0	0	0	0	0
Read/Write	—	—	—	R/W	R/W	R/W	R/W	R/W

Reserved bits

Port 8 data 4 to 0
These bits store data for port 8 pins

P8DR is initialized to H'E0 by a reset and in hardware standby mode. In software standby mode it retains its previous setting.

Table 8.14 Port 8 Pin Functions in Modes 1 to 5

Pin

Pin Functions and Selection Method

$P8_4/\overline{CS_0}$

Bit $P8_4$DDR selects the pin function as follows.

$P8_4$DDR	0	1
Pin function	$P8_4$ input	$\overline{CS_0}$ output

$P8_3/\overline{CS_1}/\overline{IRQ_3}/\overline{ADTRG}$

Bit $P8_3$DDR selects the pin function as follows.

$P8_3$DDR	0	1
Pin function	$P8_3$ input	$\overline{CS_1}$ output
	$\overline{IRQ_3}$ input	
	$\overline{ADTRG}$ input	

$P8_2/\overline{CS_2}/\overline{IRQ_2}$

The DRAM interface settings by bits DRAS2 to DRAS0 in DRCRA, and bit $P8_2$DDR, select the pin function as follows.

DRAM interface settings	(1) in table below		|(2) in table below
$P8_2$DDR	0	1	—
Pin function	$P8_2$ input	$\overline{CS_2}$ output	$\overline{CS_2}$ output*
	$\overline{IRQ_3}$ input		

Note: * $\overline{CS_2}$ is output as $\overline{RAS_2}$.

DRAM interface setting	(1)	(2)						
DRAS2	0				1			
DRAS1	0		1		0		1	
DRAS0	0	1	0	1	0	1	0	1

$P8_1/\overline{CS_3}/\overline{IRQ_1}$

The DRAM interface settings by bits DRAS2 to DRAS0 in DRCRA, and bit $P8_1$DDR, select the pin function as follows.

DRAM interface settings	(1) in table below		(2) in table below		(3) in table below
$P8_1$DDR	0	1	0	1	—
Pin function	$P8_1$ input pin	$\overline{CS_3}$ output pin	$P8_1$ input pin	$P8_1$ output pin	$\overline{CS_3}$ output pin*
	$\overline{IRQ_1}$ input pin				

Note: * $\overline{CS_3}$ is output as $\overline{RAS_3}$.

DRAM interface setting	(1)		(3)	(2)	(3)		(2)	
DRAS2	0				1			
DRAS1	0		1		0		1	
DRAS0	0	1	0	1	0	1	0	1

$P8_0/\overline{RFSH}/\overline{IRQ_0}$

Bit RFSHE in DRCRA and bit $P8_0$DDR select the pin function as follows.

RFSHE	0		1*
$P8_0$DDR	0	1	—
Pin function	$P8_0$ input	$P8_0$ output	$\overline{RFSH}$ output
	$\overline{IRQ_0}$ input		

Note: * If areas 2 to 5 are not designated as DRAM space, this bit should not be set to 1.

Table 8.15 Port 8 Pin Functions in Mode 7

Pin	Pin Functions and Selection Method		
$P8_4$	Bit $P8_4$DDR selects the pin function as follows.		
	$P8_4$DDR	0	1
	Pin function	$P8_4$ input	$P8_4$ output
$P8_3/\overline{IRQ_3}/\overline{ADTRG}$	Bit $P8_3$DDR selects the pin function as follows.		
	$P8_3$DDR	0	1
	Pin function	$P8_3$ input	$P8_3$ output
		$\overline{IRQ_3}$ input	
		$\overline{ADTRG}$ input	
$P8_2/\overline{IRQ_2}$	Bit $P8_2$DDR selects the pin function as follows.		
	$P8_2$DDR	0	1
	Pin function	$P8_2$ input	$P8_2$ output
		$\overline{IRQ_2}$ input	
$P8_1/\overline{IRQ_1}$	Bit $P8_1$DDR selects the pin function as follows.		
	$P8_1$DDR	0	1
	Pin function	$P8_1$ input	$P8_1$ output
		$\overline{IRQ_1}$ input	
$P8_0/\overline{IRQ_0}$	Bit $P8_0$DDR select the pin function as follows.		
	$P8_0$DDR	0	1
	Pin function	$P8_0$ input	$P8_0$ output
		$\overline{IRQ_0}$ input	

8.10 Port 9

8.10.1 Overview

Port 9 is a 6-bit input/output port that is also used for input and output (TxD_0, TxD_1, RxD_0, RxD_1, SCK_0, SCK_1) by serial communication interface channels 0 and 1 (SCI0 and SCI1), and for $\overline{IRQ}_5$ and $\overline{IRQ}_4$ input. See table 8.17 for the selection of pin functions.

The $\overline{IRQ}_5$ and $\overline{IRQ}_4$ functions are selected by IER settings, regardless of whether the pin is used for input or output. Caution is therefore required. For details see section 5.3.1, External Interrupts.

Port 9 has the same set of pin functions in all operating modes. Figure 8.9 shows the pin configuration of port 9.

Pins in port 9 can drive one TTL load and a 30-pF capacitive load. They can also drive a darlington transistor pair.

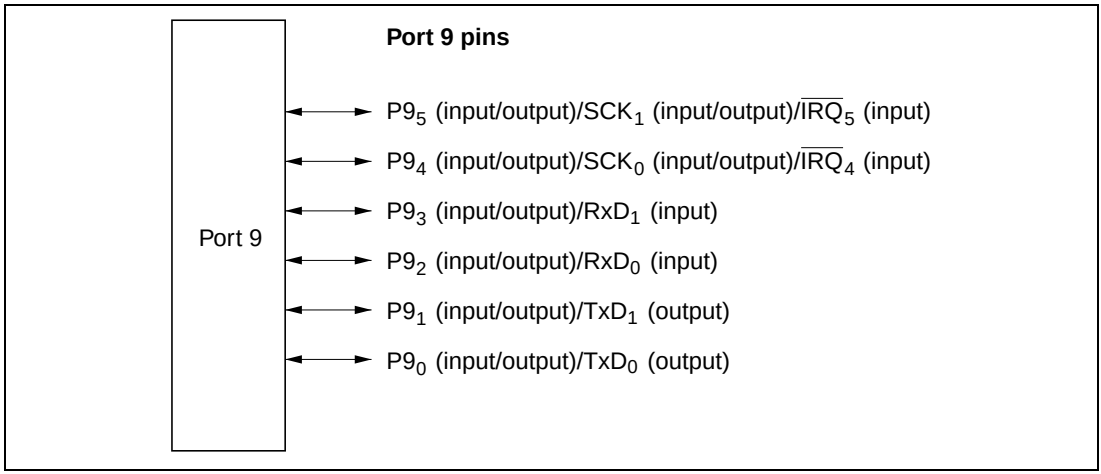


Figure 8.9 Port 9 Pin Configuration

8.10.2 Register Descriptions

Table 8.16 summarizes the registers of port 9.

Table 8.16 Port 9 Registers

Address*	Name	Abbreviation	R/W	Initial Value
H'EE008	Port 9 data direction register	P9DDR	W	H'C0
H'FFFD8	Port 9 data register	P9DR	R/W	H'C0

Note: * Lower 20 bits of the address in advanced mode.

Port 9 Data Direction Register (P9DDR): P9DDR is an 8-bit write-only register that can select input or output for each pin in port 9.

Bits 7 and 6 are reserved. They are fixed at 1, and cannot be modified.

Bit	7	6	5	4	3	2	1	0
	—	—	$P9_5DDR$	$P9_4DDR$	$P9_3DDR$	$P9_2DDR$	$P9_1DDR$	$P9_0DDR$
Initial value	1	1	0	0	0	0	0	0
Read/Write	—	—	W	W	W	W	W	W

Reserved bits

Port 9 data direction 5 to 0
These bits select input or output for port 9 pins

When port 9 functions as an input/output port, a pin in port 9 becomes an output port if the corresponding P9DDR bit is set to 1, and an input port if this bit is cleared to 0. For the method of selecting the pin functions, see table 8.17.

P9DDR is a write-only register. Its value cannot be read. All bits return 1 when read.

P9DDR is initialized to H'C0 by a reset and in hardware standby mode. In software standby mode it retains its previous setting. Therefore, if a transition is made to software standby mode while port 9 is functioning as an input/output port and a P9DDR bit is set to 1, the corresponding pin maintains its output state.

Port 9 Data Register (P9DR): P9DR is an 8-bit readable/writable register that stores output data for port 9. When port 9 functions as an output port, the value of this register is output. When a bit in P9DDR is set to 1, if port 9 is read the value of the corresponding P9DR bit is returned. When a bit in P9DDR is cleared to 0, if port 9 is read the corresponding pin logic level is read.

Bits 7 and 6 are reserved. They are fixed at 1, and cannot be modified.

Bit	7	6	5	4	3	2	1	0
	—	—	$P9_5$	$P9_4$	$P9_3$	$P9_2$	$P9_1$	$P9_0$
Initial value	1	1	0	0	0	0	0	0
Read/Write	—	—	R/W	R/W	R/W	R/W	R/W	R/W

Reserved bits

Port 9 data 5 to 0
These bits store data for port 9 pins

P9DR is initialized to H'C0 by a reset and in hardware standby mode. In software standby mode it retains its previous setting.

Table 8.17 Port 9 Pin Functions

Pin	Pin Functions and Selection Method
$P9_5/SCK_1/\overline{IRQ}_5$	Bit C/$\overline{A}$ in SMR of SCI1, bits CKE0 and CKE1 in SCR, and bit $P9_5$DDR select the pin function as follows.

CKE1	0				1
C/$\overline{A}$	0			1	—
CKE0	0		1	—	—
$P9_5$DDR	0	1	—	—	—
Pin function	$P9_5$ input	$P9_5$ output	SCK_1 output	SCK_1 output	SCK_1 input
	$\overline{IRQ}_5$ input				

$P9_4/SCK_0/\overline{IRQ}_4$	Bit C/$\overline{A}$ in SMR of SCI0, bits CKE0 and CKE1 in SCR, and bit $P9_4$DDR select the pin function as follows.

CKE1	0				1
C/$\overline{A}$	0			1	—
CKE0	0		1	—	—
$P9_4$DDR	0	1	—	—	—
Pin function	$P9_4$ input	$P9_4$ output	SCK_0 output	SCK_0 output	SCK_0 input
	$\overline{IRQ}_4$ input				

$P9_3/RxD_1$	Bit RE in SCR of SCI1, bit SMIF in SCMR, and bit $P9_3$DDR select the pin function as follows.

SMIF	0			1
RE	0		1	—
$P9_3$DDR	0	1	—	—
Pin function	$P9_3$ input	$P9_3$ output	RxD_1 input	RxD_1 input

$P9_2/RxD_0$	Bit RE in SCR of SCI0, bit SMIF in SCMR, and bit $P9_2$DDR select the pin function as follows.

SMIF	0			1
RE	0		1	—
$P9_2$DDR	0	1	—	—
Pin function	$P9_2$ input	$P9_2$ output	RxD_0 input	RxD_0 input

Pin	Pin Functions and Selection Method
$P9_1/TxD_1$	Bit TE in SCR of SCI1, bit SMIF in SCMR, and bit $P9_1$DDR select the pin function as follows.

SMIF	0			1
TE	0		1	—
$P9_1$ DDR	0	1	—	—
Pin function	$P9_1$ input	$P9_1$ output	TxD_1 output	TxD_1 output*

Note: * Functions as the TxD_1 output pin, but there are two states: one in which the pin is driven, and another in which the pin is at high-impedance.

$P9_0/TxD_0$	Bit TE in SCR of SCI0, bit SMIF in SCMR, and bit $P9_0$DDR select the pin function as follows.

SMIF	0			1
TE	0		1	—
$P9_0$DDR	0	1	—	—
Pin function	$P9_0$ input	$P9_0$ output	TxD_0 output	TxD_0 output*

Note: * Functions as the TxD_0 output pin, but there are two states: one in which the pin is driven, and another in which the pin is at high-impedance.

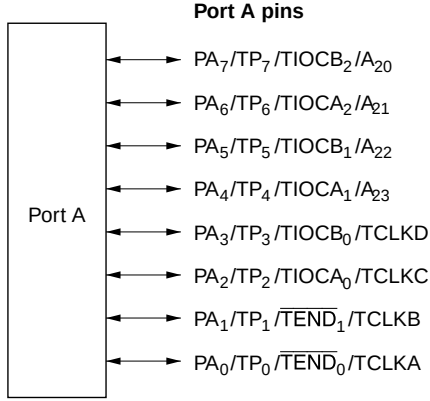
8.11 Port A

8.11.1 Overview

Port A is an 8-bit input/output port that is also used for output (TP_7 to TP_0) from the programmable timing pattern controller (TPC), input and output, ($TIOCB_2$, $TIOCA_2$, $TIOCB_1$, $TIOCA_1$, $TIOCB_0$, $TIOCA_0$, TCLKD, TCLKC, TCLKB, TCLKA) by the 16-bit timer, input (TCLKD, TCLKC, TCLKB, TCLKA) to the 8-bit timer, output ($\overline{TEND}_1$, $\overline{TEND}_0$) from the DMA controller (DMAC), and address output (A_{23} to A_{20}). A reset or hardware standby transition leaves port A as an input port, except that in modes 3 and 4, one pin is always used for A_{20} output. See table 8.19 to 8.21 for the selection of pin functions.

Usage of pins for TPC, 16-bit timer, 8-bit timer, and DMAC input and output is described in the sections on those modules. For output of address bits A_{23} to A_{20} in modes 3, 4, and 5, see section 6.2.4, Bus Release Control Register (BRCR). Pins not assigned to any of these functions are available for generic input/output. Figure 8.10 shows the pin configuration of port A.

Pins in port A can drive one TTL load and a 30-pF capacitive load. They can also drive a darlington transistor pair. Port A has Schmitt-trigger inputs.



Pin functions in modes 1, 2, and 7

PA 7 (input/output)/TP 7 (output)/TIOCB 2 (input/output)
PA 6 (input/output)/TP 6 (output)/TIOCA 2 (input/output)
PA 5 (input/output)/TP 5 (output)/TIOCB 1 (input/output)
PA 4 (input/output)/TP 4 (output)/TIOCA 1 (input/output)
PA 3 (input/output)/TP 3 (output)/TIOCB 0 (input/output)/TCLKD (input)
PA 2 (input/output)/TP 2 (output)/TIOCA 0 (input/output)/TCLKC (input)
PA 1 (input/output)/TP 1 (output)/$\overline{\text{TEND}}$ 1 (output)/TCLKB (input)
PA 0 (input/output)/TP 0 (output)/$\overline{\text{TEND}}$ 0 (output)/TCLKA (input)

Pin functions in modes 3 and 4

A 20 (output)
PA 6 (input/output)/TP 6 (output)/TIOCA 2 (input/output)/A 21 (output)
PA 5 (input/output)/TP 5 (output)/TIOCB 1 (input/output)/A 22 (output)
PA 4 (input/output)/TP 4 (output)/TIOCA 1 (input/output)/A 23 (output)
PA 3 (input/output)/TP 3 (output)/TIOCB 0 (input/output)/TCLKD (input)
PA 2 (input/output)/TP 2 (output)/TIOCA 0 (input/output)/TCLKC (input)
PA 1 (input/output)/TP 1 (output)/$\overline{\text{TEND}}$ 1 (output)/TCLKB (input)
PA 0 (input/output)/TP 0 (output)/$\overline{\text{TEND}}$ 0 (output)/TCLKA (input)

Pin functions in mode 5

PA 7 (input/output)/TP 7 (output)/TIOCB 2 (input/output)/A 20 (output)
PA 6 (input/output)/TP 6 (output)/TIOCA 2 (input/output)/A 21 (output)
PA 5 (input/output)/TP 5 (output)/TIOCB 1 (input/output)/A 22 (output)
PA 4 (input/output)/TP 4 (output)/TIOCA 1 (input/output)/A 23 (output)
PA 3 (input/output)/TP 3 (output)/TIOCB 0 (input/output)/TCLKD (input)
PA 2 (input/output)/TP 2 (output)/TIOCA 0 (input/output)/TCLKC (input)
PA 1 (input/output)/TP 1 (output)/$\overline{\text{TEND}}$ 1 (output)/TCLKB (input)
PA 0 (input/output)/TP 0 (output)/$\overline{\text{TEND}}$ 0 (output)/TCLKA (input)

Figure 8.10 Port A Pin Configuration

8.11.2 Register Descriptions

Table 8.18 summarizes the registers of port A.

Table 8.18 Port A Registers

Address*	Name	Abbreviation	R/W	Initial Value	
				Modes 1, 2, 5, and 7	Modes 3, 4
H'EE009	Port A data direction register	PADDR	W	H'00	H'80
H'FFFD9	Port A data register	PADR	R/W	H'00	H'00

Note: * Lower 20 bits of the address in advanced mode.

Port A Data Direction Register (PADDR): PADDR is an 8-bit write-only register that can select input or output for each pin in port A. When pins are used for TPC output, the corresponding PADDR bits must also be set.

Bit		7	6	5	4	3	2	1	0
		PA_7DDR	PA_6DDR	PA_5DDR	PA_4DDR	PA_3DDR	PA_2DDR	PA_1DDR	PA_0DDR
Modes 3, 4	Initial value	1	0	0	0	0	0	0	0
	Read/Write	—	W	W	W	W	W	W	W
Modes 1, 2, 5, and 7	Initial value	0	0	0	0	0	0	0	0
	Read/Write	W	W	W	W	W	W	W	W

Port A data direction 7 to 0
These bits select input or output for port A pins

The pin functions that can be selected for pins PA_7 to PA_4 differ between modes 1, 2, and 7, and modes 3 to 5. For the method of selecting the pin functions, see tables 8.19 and 8.20.

The pin functions that can be selected for pins PA_3 to PA_0 are the same in modes 1 to 5, 7. For the method of selecting the pin functions, see table 8.21.

When port A functions as an input/output port, a pin in port A becomes an output port if the corresponding PADDR bit is set to 1, and an input port if this bit is cleared to 0. In modes 3 and 4, PA_7DDR is fixed at 1 and PA_7 functions as the A_{20} address output pin.

PADDR is a write-only register. Its value cannot be read. All bits return 1 when read.

PADDR is initialized to H'00 by a reset and in hardware standby mode in modes 1, 2, 5, and 7. It is initialized to H'80 by a reset and in hardware standby mode in modes 3 and 4. In software

standby mode it retains its previous setting. Therefore, if a transition is made to software standby mode while port A is functioning as an input/output port and a PADDR bit is set to 1, the corresponding pin maintains its output state.

Port A Data Register (PADR): PADR is an 8-bit readable/writable register that stores output data for port A. When port A functions as an output port, the value of this register is output. When a bit in PADDR is set to 1, if port A is read the value of the corresponding PADR bit is returned. When a bit in PADDR is cleared to 0, if port A is read the corresponding pin logic level is read.

Bit	7	6	5	4	3	2	1	0
	PA_7	PA_6	PA_5	PA_4	PA_3	PA_2	PA_1	PA_0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Port A data 7 to 0
These bits store data for port A pins

PADR is initialized to H'00 by a reset and in hardware standby mode. In software standby mode it retains its previous setting.

Table 8.19 Port A Pin Functions (Modes 1, 2, 7)

Pin	Pin Functions and Selection Method
$PA_7/TP_7/TIOCB_2$	Bit PWM2 in TMDR, bits IOB2 to IOB0 in TIOR2, bit NDER7 in NDERA, and bit PA_7DDR select the pin function as follows.

16-bit timer channel 2 settings	(1) in table below	(2) in table below		
PA_7DDR	—	0	1	1
NDER7	—	—	0	1
Pin function	$TIOCB_2$ output	PA_7 input	PA_7 output	TP_7 output
		$TIOCB_2$ input*		

Note: * $TIOCB_2$ input when IOB2 = 1 and PWM2 = 0.

16-bit timer channel 2 settings	(2)	(1)		(2)
IOB2	0			1
IOB1	0	0	1	—
IOB0	0	1	—	—

Pin	Pin Functions and Selection Method
$PA_6/TP_6/TIOCA_2$	Bit PWM2 in TMDR, bits IOA2 to IOA0 in TIOR2, bit NDER6 in NDERA, and bit PA_6DDR select the pin function as follows.

16-bit timer channel 2 settings	(1) in table below	(2) in table below		
PA_6DDR	—	0	1	1
NDER6	—	—	0	1
Pin function	$TIOCA_2$ output	PA_6 input	PA_6 output	TP_6 output
		$TIOCA_2$ input*		

Note: * $TIOCA_2$ input when IOA2 = 1.

16-bit timer channel 2 settings	(2)	(1)		(2)	(1)
PWM2	0				1
IOA2	0			1	—
IOA1	0	0	1	—	—
IOA0	0	1	—	—	—

$PA_5/TP_5/TIOCB_1$	Bit PWM1 in TMDR, bits IOB2 to IOB0 in TIOR1, bit NDER5 in NDERA, and bit PA_5DDR select the pin function as follows.

16-bit timer channel 1 settings	(1) in table below	(2) in table below		
PA_5DDR	—	0	1	1
NDER5	—	—	0	1
Pin function	$TIOCB_1$ output	PA_5 input	PA_5 output	TP_5 output
		$TIOCB_1$ input*		

Note: * $TIOCB_1$ input when IOB2 = 1 and PWM1 = 0.

16-bit timer channel 1 settings	(2)	(1)		(2)
IOB2	0			1
IOB1	0	0	1	—
IOB0	0	1	—	—

Pin	Pin Functions and Selection Method
PA_4/TP_4/ $TIOCA_1$	Bit PWM1 in TMDR, bits IOA2 to IOA0 in TIOR1, bit NDER4 in NDERA, and bit PA_4DDR select the pin function as follows.

16-bit timer channel 1 settings	(1) in table below	(2) in table below		
PA_4DDR	—	0	1	1
NDER4	—	—	0	1
Pin function	$TIOCA_1$ output	PA_4 input	PA_4 output	TP_4 output
		$TIOCA_1$ input*		

Note: * $TIOCA_1$ input when IOA2 = 1.

16-bit timer channel 1 settings	(2)	(1)		(2)	(1)
PWM1	0				1
IOA2	0			1	—
IOA1	0	0	1	—	—
IOA0	0	1	—	—	—

Table 8.20 Port A Pin Functions (Modes 3 to 5)

Pin | **Pin Functions and Selection Method**

$PA_7/TP_7/$ $TIOCB_2/A_{20}$

Modes 3 and 4: Always used as A_{20} output.

Pin function	A_{20} output

Mode 5:

Bit PWM2 in TMDR, bits IOB2 to IOB0 in TIOR2, bit NDER7 in NDERA, bit A20E in BRCR, and bit PA_7DDR select the pin function as follows.

A20E	1				0
16-bit timer channel 2 settings	(1) in table below	(2) in table below			—
PA_7DDR	—	0	1	1	—
NDER7	—	—	0	1	—
Pin function	$TIOCB_2$ output	PA_7 input	PA_7 output	TP_7 output	A_{20} output
		$TIOCB_2$ input*			

Note: * $TIOCB_2$ input when IOB2 = 1 and PWM2 = 0.

16-bit timer channel 2 settings	(2)	(1)		(2)
IOB2	0			1
IOB1	0	0	1	—
IOB0	0	1	—	—

$PA_6/TP_6/$ $TIOCA_2/A_{21}$

Bit PWM2 in TMDR, bits IOA2 to IOA0 in TIOR2, bit NDER6 in NDERA, bit A21E in BRCR, and bit PA_6DDR select the pin function as follows.

A21E	1				0
16-bit timer channel 2 settings	(1) in table below	(2) in table below			—
PA_6DDR	—	0	1	1	—
NDER6	—	—	0	1	—
Pin function	$TIOCA_2$ output	PA_6 input	PA_6 output	TP_6 output	A_{21} output
		$TIOCA_2$ input*			

Note: * $TIOCA_2$ input when IOA2 = 1.

16-bit timer channel 2 settings	(2)	(1)		(2)	(1)
PWM2	0				1
IOA2	0			1	—
IOA1	0	0	1	—	—
IOA0	0	1	—	—	—

Pin	Pin Functions and Selection Method
$PA_5/TP_5/TIOCB_1/A_{22}$	Bit PWM1 in TMDR, bits IOB2 to IOB0 in TIOR1, bit NDER5 in NDERA, bit A22E in BRCR, and bit PA_5DDR select the pin function as follows.

A22E	1				0
16-bit timer channel 1 settings	(1) in table below	(2) in table below			—
PA_5DDR	—	0	1	1	—
NDER5	—	—	0	1	—
Pin function	$TIOCB_1$ output	PA_5 input	PA_5 output	TP_5 output	A_{22} output
		$TIOCB_1$ input*			

Note: * $TIOCB_1$ input when IOB2 = 1 and PWM1 = 0.

16-bit timer channel 1 settings	(2)	(1)		(2)
IOB2	0			1
IOB1	0	0	1	—
IOB0	0	1	—	—

$PA_4/TP_4/TIOCA_1/A_{23}$	Bit PWM1 in TMDR, bits IOA2 to IOA0 in TIOR1, bit NDER4 in NDERA, bit A23E in BRCR, and bit PA_4DDR select the pin function as follows.

A23E	1				0
16-bit timer channel 1 settings	(1) in table below	(2) in table below			—
PA_4DDR	—	0	1	1	—
NDER4	—	—	0	1	—
Pin function	$TIOCA_1$ output	PA_4 input	PA_4 output	TP_4 output	A_{23} output
		$TIOCA_1$ input*			

Note: * $TIOCA_1$ input when IOA2 = 1.

16-bit timer channel 1 settings	(2)	(1)		(2)	(1)
PWM1	0				1
IOA2	0			1	—
IOA1	0	0	1	—	—
IOA0	0	1	—	—	—

Table 8.21 Port A Pin Functions (Modes 1 to 5, 7)

Pin	Pin Functions and Selection Method

$PA_3/TP_3/TIOCB_0/TCLKD$

Bit PWM0 in TMDR, bits IOB2 to IOB0 in TIOR0, bits TPSC2 to TPSC0 in 16TCR2 to 16TCR0 of the 16-bit timer, bits CKS2 to CKS0 in 8TCR2 of the 8-bit timer, bit NDER3 in NDERA, and bit PA_3DDR select the pin function as follows.

16-bit timer channel 0 settings	(1) in table below	(2) in table below		
PA_3DDR	—	0	1	1
NDER3	—	—	0	1
Pin function	$TIOCB_0$ output	PA_3 input	PA_3 output	TP_3 output
		$TIOCB_0$ input*1		
	TCLKD input*2			

Notes: 1. $TIOCB_0$ input when IOB2 = 1 and PWM0 = 0.

2. TCLKD input when TPSC2 = TPSC1 = TPSC0 = 1 in any of 16TCR2 to 16TCR0, or bits CKS2 to CKS0 in 8TCR2 are as shown in (3) in the table below.

16-bit timer channel 0 settings	(2)	(1)		(2)
IOB2	0			1
IOB1	0	0	1	—
IOB0	0	1	—	—

8-bit timer channel 2 settings	(4)	(3)		
CKS2	0	1		
CKS1	—	0		1
CKS0	—	0	1	—

Pin	Pin Functions and Selection Method
$PA_2/TP_2/TIOCA_0/TCLKC$	Bit PWM0 in TMDR, bits IOA2 to IOA0 in TIOR0, bits TPSC2 to TPSC0 in 16TCR2 to 16TCR0 of the 16-bit timer, bits CKS2 to CKS0 in 8TCR0 of the 8-bit timer, bit NDER2 in NDERA, and bit PA_2DDR select the pin function as follows.

16-bit timer channel 0 settings	(1) in table below	(2) in table below		
PA_2DDR	—	0	1	1
NDER2	—	—	0	1
Pin function	$TIOCA_0$ output	PA_2 input	PA_2 output	TP_2 output
		$TIOCA_0$ input*[1]		
	TCLKC input*[2]			

Notes: 1. $TIOCA_0$ input when IOA2 = 1.

2. TCLKC input when TPSC2 = TPSC1 = 1 and TPSC0 = 0 in any of 16TCR2 to 16TCR0, or bits CKS2 to CKS0 in 8TCR0 are as shown in (3) in the table below.

16-bit timer channel 0 settings	(2)	(1)		(2)	(1)
PWM0	0				1
IOA2	0			1	—
IOA1	0	0	1	—	—
IOA0	0	1	—	—	—

8-bit timer channel 0 settings	(4)	(3)		
CKS2	0	1		
CKS1	—	0		1
CKS0	—	0	1	—

Pin	Pin Functions and Selection Method

$PA_1/TP_1/TCLKB/\overline{TEND}_1$

Bit MDF in TMDR, bits TPSC2 to TPSC0 in 16TCR2 to 16TCR0 of the 16-bit timer, bits CKS2 to CKS0 in 8TCR3 of the 8-bit timer, bit NDER1 in NDERA, and bit PA_1DDR select the pin function as follows.

PA_1DDR	0	1	1
NDER1	—	0	1
Pin function	PA_1 input	PA_1 output	TP_1 output
	TCLKB output*1		
	$\overline{TEND}_1$ output*2		

Notes: 1. TCLKB input when MDF = 1 in TMDR, or TPSC2 = 1, TPSC1 = 0, and TPSC0 = 1 in any of 16TCR2 to 16TCR0, or bits CKS2 to CKS0 in 8TCR3 are as shown in (1) in the table below.

2. When an external request is specified as a DMAC activation source, $\overline{TEND}_1$ output regardless of bits PA_1DDR and NDER1.

8-bit timer channel 3 settings	(2)		(1)	
CKS2	0	1		
CKS1	—	0		1
CKS0	—	0	1	—

$PA_0/TP_0/TCLKA/\overline{TEND}_0$

Bit MDF in TMDR, bits TPSC2 to TPSC0 in 16TCR2 to 16TCR0 of the 16-bit timer, bits CKS2 to CKS0 in 8TCR1 of the 8-bit timer, bit NDER0 in NDERA, and bit PA_0DDR select the pin function as follows.

PA_0DDR	0	1	
NDER0	—	0	1
Pin function	PA_0 input	PA_0 output	TP_0 output
	TCLKA output*1		
	$\overline{TEND}_0$ output*2		

Notes: 1. TCLKA input when MDF = 1 in TMDR, or TPSC2 = 1, TPSC1 = 0 and TPSC0 = 0 in any of 16TCR2 to 16TCR0, or bits CKS2 to CKS0 in 8TCR0 are as shown in (1) in the table below.

2. When an external request is specified as a DMAC activation source, $\overline{TEND}_0$ output regardless of bits PA_0DDR and NDER0.

8-bit timer channel 1 settings	(2)		(1)	
CKS2	0	1		
CKS1	—	0		1
CKS0	—	0	1	—

8.12 Port B

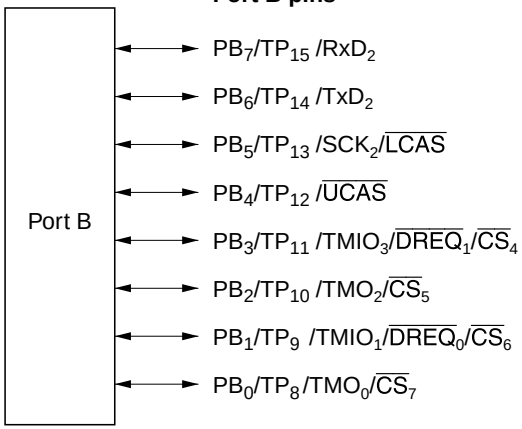
8.12.1 Overview

Port B is an 8-bit input/output port that is also used for output (TP_{15} to TP_8) from the programmable timing pattern controller (TPC), input/output ($TMIO_3$, TMO_2, $TMIO_1$, TMO_0) by the 8-bit timer, $\overline{CS}_7$ to $\overline{CS}_4$ output, input ($\overline{DREQ}_1$, $\overline{DREQ}_0$) to the DMA controller (DMAC), input and output (TxD_2, RxD_2, SCK_2) by serial communication interface channel 2 (SCI2), and output ($\overline{UCAS}$, $\overline{LCAS}$) by the DRAM interface. See table 8.23 to 8.24 for the selection of pin functions. A reset or hardware standby transition leaves port B as an input port.

For output of $\overline{CS}_7$ to $\overline{CS}_4$ in modes 1 to 5, see section 6.3.4, Chip Select Signals. Pins not assigned to any of these functions are available for generic input/output. Figure 8.11 shows the pin configuration of port B.

When DRAM is connected to areas 2, 3, 4, and 5, the $\overline{CS}_4$ and $\overline{CS}_5$ output pins become $\overline{RAS}$ output pins for these areas. For details see section 6.5, DRAM Interface.

Pins in port B can drive one TTL load and a 30-pF capacitive load. They can also drive darlington transistor pair.



Pin functions in modes 1 to 5

PB_7 (input/output)/TP_{15} (output) /RxD_2 (input)

PB_6 (input/output)/TP_{14} (output) /TxD_2 (output)

PB_5 (input/output)/TP_{13} (output) /SCK_2 (input/output) /$\overline{LCAS}$ (output)

PB_4 (input/output)/TP_{12} (output) /$\overline{UCAS}$ (output)

PB_3 (input/output)/TP_{11} (output) /$TMIO_3$ (input/output) /$\overline{DREQ}_1$ (input) $\overline{CS}_4$ (output)

PB_2 (input/output)/TP_{10} (output) /TMO_2 (output) /$\overline{CS}_5$ (output)

PB_1 (input/output)/TP_9 (output) /$TMIO_1$ (input/output) /$\overline{DREQ}_0$ (input) /$\overline{CS}_6$ (output)

PB_0 (input/output)/TP_8 (output) /TMO_0 (output) /$\overline{CS}_7$ (output)

Pin functions in mode 7

PB_7 (input/output)/TP_{15} (output) /RxD_2 (input)

PB_6 (input/output)/TP_{14} (output) /TxD_2 (output)

PB_5 (input/output)/TP_{13} (output) /SCK_2 (input/output)

PB_4 (input/output)/TP_{12} (output)

PB_3 (input/output)/TP_{11} (output) /$TMIO_3$ (input/output) /$\overline{DREQ}_1$ (input)

PB_2 (input/output)/TP_{10} (output) /TMO_2 (output)

PB_1 (input/output)/TP_9 (output) /$TMIO_1$ (input/output) /$\overline{DREQ}_0$ (input)

PB_0 (input/output)/TP_8 (output) /TMO_0 (output)

Figure 8.11 Port B Pin Configuration

8.12.2 Register Descriptions

Table 8.22 summarizes the registers of port B.

Table 8.22 Port B Registers

Address*	Name	Abbreviation	R/W	Initial Value
H'EE00A	Port B data direction register	PBDDR	W	H'00
H'FFFDA	Port B data register	PBDR	R/W	H'00

Note: * Lower 20 bits of the address in advanced mode.

Port B Data Direction Register (PBDDR): PBDDR is an 8-bit write-only register that can select input or output for each pin in port B. When pins are used for TPC output, the corresponding PBDDR bits must also be set.

Bit	7	6	5	4	3	2	1	0
	PB_7DDR	PB_6DDR	PB_5DDR	PB_4DDR	PB_3DDR	PB_2DDR	PB_1DDR	PB_0DDR
Initial value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W

Port B data direction 7 to 0
These bits select input or output for port B pins

The pin functions that can be selected for port B differ between modes 1 to 5, and mode 7. For the method of selecting the pin functions, see tables 8.23 and 8.24.

When port B functions as an input/output port, a pin in port B becomes an output port if the corresponding PBDDR bit is set to 1, and an input port if this bit is cleared to 0.

PBDDR is a write-only register. Its value cannot be read. All bits return 1 when read.

PBDDR is initialized to H'00 by a reset and in hardware standby mode. In software standby mode it retains its previous setting. Therefore, if a transition is made to software standby mode while port B is functioning as an input/output port and a PBDDR bit is set to 1, the corresponding pin maintains its output state.

Port B Data Register (PBDR): PBDR is an 8-bit readable/writable register that stores output data for pins port B. When port B functions as an output port, the value of this register is output. When a bit in PBDDR is set to 1, if port B is read the value of the corresponding PBDR bit is returned. When a bit in PBDDR is cleared to 0, if port B is read the corresponding pin logic level is read.

Bit	7	6	5	4	3	2	1	0
	PB_7	PB_6	PB_5	PB_4	PB_3	PB_2	PB_1	PB_0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Port B data 7 to 0
These bits store data for port B pins

PBDR is initialized to H'00 by a reset and in hardware standby mode. In software standby mode it retains its previous setting.

Table 8.23 Port B Pin Functions (Modes 1 to 5)

Pin	Pin Functions and Selection Method

$PB_7/TP_{15}/RxD_2$

Bit RE in SCR of SCI2, bit SMIF in SCMR, bit NDER15 in NDERB, and bit PB_7DDR select the pin function as follows.

SMIF	0				1
RE	0			1	—
PB_7DDR	0	1	1	—	—
NDER15	—	0	1	—	—
Pin function	PB_7 input	PB_7 output	TP_{15} output	RxD_2 input	RxD_2 input

$PB_6/TP_{14}/TxD_2$

Bit TE in SCR of SCI2, bit SMIF in SCMR, bit NDER14 in NDERB, and bit PB_6DDR select the pin function as follows.

SMIF	0				1
TE	0			1	—
PB_6DDR	0	1	1	—	—
NDER14	—	0	1	—	—
Pin function	PB_6 input	PB_6 output	TP_{14} output	TxD_2 output	TxD_2 output*

Note: * Functions as the TxD_2 output pin, but there are two states: one in which the pin is driven, and another in which the pin is at high-impedance.

$PB_5/TP_{13}/SCK_2/\overline{LCAS}$

Bit C/$\overline{A}$ in SMR of SCI2, bits CKE0 and CKE1 in SCR, bit NDER13 in NDERB, and bit PB_5DDR select the pin function as follows.

CKE1	0					1
C/$\overline{A}$	0				1	—
CKE0	0			1	—	—
PB_5DDR	0	1	1	—	—	—
NDER13	—	0	1	—	—	—
Pin function	PB_5 input	PB_5 output	TP_{13} output	SCK_2 output	SCK_2 output	SCK_2 input
	$\overline{LCAS}$ output*					

Note: * $\overline{LCAS}$ output depending on bits DRAS2 to DRAS0 in DRCRA and bit CSEL in DRCRB, and regardless of bits C/$\overline{A}$, CKE0 and CKE1, NDER13, and PB_5DDR. For details, see section 6, Bus Controller.

$PB_4/TP_{12}/\overline{UCAS}$

Bit NDER12 in NDERB and bit PB_4DDR select the pin function as follows.

PB_4DDR	0	1	1
NDER12	—	0	1
Pin function	PB_4 input	PB_4 output	TP_{12} output
	$\overline{UCAS}$ output*		

Note: * $\overline{UCAS}$ output depending on bits DRAS2 to DRAS0 in DRCRA and bit CSEL in DRCRB, and regardless of bits NDER12 and PB_4DDR. For details, see section 6, Bus Controller.

Pin	Pin Functions and Selection Method

PB_3/TP_{11}/ $TMIO_3$/ $\overline{DREQ}_1$/$\overline{CS}_4$

The DRAM interface settings by bits DRAS2 to DRAS0 in DRCRA, bits OIS3/2 and OS1/0 in 8TCSR3, bits CCLR1 and CCLR0 in 8TCR3, bit CS4E in CSCR, bit NDER11 in NDERB, and bit PB_3DDR select the pin function as follows.

DRAM interface settings	(1) in table below					(2) in table below
OIS3/2 and OS1/0	All 0				Not all 0	—
CS4E	0			1	—	—
PB_3DDR	0	1	1	—	—	—
NDER11	—	0	1	—	—	—
Pin function	PB_3 input	PB_3 output	TP_{11} output	$\overline{CS}_4$ output	$TMIO_3$ output	$\overline{CS}_4$ output*3
	$TMIO_3$ input*1					
	$\overline{DREQ}_1$ input*2					

Notes:
1. $TMIO_3$ input when CCLR1 = CCLR0 = 1.
2. When an external request is specified as a DMAC activation source, $\overline{DREQ}_1$ input regardless of bits OIS3 and OIS2, OS1 and OS0, CCLR1 and CCLR0, CS4E, NDER11, and PB_3DDR.
3. $\overline{CS}_4$ is output as $\overline{RAS}_4$.

DRAM interface settings	(1)				(2)			(1)
DRAS2	0				1			
DRAS1	0		1		0		1	
DRAS0	0	1	0	1	0	1	0	1

PB_2/TP_{10}/ TMO_2/$\overline{CS}_5$

The DRAM interface settings by bits DRAS2 to DRAS0 in DRCRA, bits OIS3/2 and OS1/0 in 8TCSR2, bit CS5E in CSCR, bit NDER10 in NDERB, and bit PB_2DDR select the pin function as follows.

DRAM interface settings	(1) in table below					(2) in table below
OIS3/2 and OS1/0	All 0				Not all 0	—
CS5E	0			1	—	—
PB_2DDR	0	1	1	—	—	—
NDER10	—	0	1	—	—	—
Pin function	PB_2 input	PB_2 output	TP_{10} output	$\overline{CS}_5$ output	$TMIO_2$ output	$\overline{CS}_5$ output*

Note: * $\overline{CS}_5$ is output as $\overline{RAS}_5$.

DRAM interface settings	(1)				(2)		(1)	
DRAS2	0				1			
DRAS1	0		1		0		1	
DRAS0	0	1	0	1	0	1	0	1

Pin	Pin Functions and Selection Method
$PB_1/TP_9/TMIO_1/\overline{DREQ_0}/\overline{CS_6}$	Bits OIS3/2 and OS1/0 in 8TCSR1, bits CCLR1 and CCLR0 in TCR1, bit CS6E in CSCR, bit NDER9 in NDERB, and bit PB_1DDR select the pin function as follows.

OIS3/2 and OS1/0	All 0				Not all 0
CS6E	0			1	—
PB_1DDR	0	1	1	—	—
NDER9	—	0	1	—	—
Pin function	PB_1 input	PB_1 output	TP_9 output	$\overline{CS_6}$ output	$TMIO_1$ output
	$TMIO_1$ input*1				
	$\overline{DREQ_0}$ input*2				

Notes: 1. $TMIO_1$ input when CCLR1 = CCLR0 = 1.

2. When an external request is specified as a DMAC activation source, $\overline{DREQ_0}$ input regardless of bits OIS3/2 and OS1/0, bits CCLR1/0, bit CS6E, bit NDER9, and bit PB_1DDR.

$PB_0/TP_8/TMO_0/\overline{CS_7}$	Bits OIS3/2 and OS1/0 in 8TCSR0, bit CS7E in CSCR, bit NDER8 in NDERB, and bit PB_0DDR select the pin function as follows.

OIS3/2 and OS1/0	All 0				Not all 0
CS7E	0			1	—
PB_0DDR	0	1	1	—	—
NDER8	—	0	1	—	—
Pin function	PB_0 input	PB_0 output	TP_8 output	$\overline{CS_7}$ output	TMO_0 output

Table 8.24 Port B Pin Functions (Mode 7)

Pin	Pin Functions and Selection Method
$PB_7/TP_{15}/RxD_2$	Bit RE in SCR of SCI2, bit SMIF in SCMR, bit NDER15 in NDERB, and bit PB_7DDR select the pin function as follows.

SMIF	0				1
RE	0			1	—
PB_7DDR	0	1	1	—	—
NDER15	—	0	1	—	—
Pin function	PB_7 input	PB_7 output	TP_{15} output	RxD_2 input	RxD_2 input

$PB_6/TP_{14}/TxD_2$	Bit TE in SCR of SCI2, bit SMIF in SCMR, bit NDER14 in NDERB, and bit PB_6DDR select the pin function as follows.

SMIF	0				1
TE	0			1	—
PB_6DDR	0	1	1	—	—
NDER14	—	0	1	—	—
Pin function	PB_6 input	PB_6 output	TP_{14} output	TxD_2 output	TxD_2 output*

Note: * Functions as the TxD2 output pin, but there are two states: one in which the pin is driven, and another in which the pin is at high-impedance.

$PB_5/TP_{13}/SCK_2$	Bit C/$\overline{A}$ in SMR of SCI2, bits CKE0 and CKE1 in SCR, bit NDER13 in NDERB, and bit PB_5DDR select the pin function as follows.

CKE1	0					1
C/$\overline{A}$	0				1	—
CKE0	0			1	—	—
PB_5DDR	0	1	1	—	—	—
NDER13	—	0	1	—	—	—
Pin function	PB_5 input	PB_5 output	TP_{13} output	SCK_2 output	SCK_2 output	SCK_2 input

PB_4/TP_{12}	Bit NDER12 in NDERB and bit PB_4DDR select the pin function as follows.

PB_4DDR	0	1	1
NDER12	—	0	1
Pin function	PB_4 input	PB_4 output	TP_{12} output

Pin	Pin Functions and Selection Method

PB_3/TP_{11}/ $TMIO_3$/ $\overline{DREQ}_1$

Bits OIS3/2 and OS1/0 in 8TCSR3, bits CCLR1 and CCLR0 in 8TCR3, bit NDER11 in NDERB, and bit PB_3DDR select the pin function as follows.

OIS3/2 and OS1/0	All 0			Not all 0
PB_3DDR	0	1	1	—
NDER11	—	0	1	—
Pin function	PB_3 input	PB_3 output	TP_{11} output	$TMIO_3$ output
	$TMIO_3$ input*1			
	$\overline{DREQ}_1$ input*2			

Notes: 1. $TMIO_3$ input when CCLR1 = CCLR0 = 1.

2. When an external request is specified as a DMAC activation source, $\overline{DREQ}_1$ input regardless of bits OIS3/2 and OS1/0, bit NDER11, and bit PB_3DDR.

PB_2/TP_{10}/ TMO_2

Bits OIS3/2 and OS1/0 in 8TCSR2, bit NDER10 in NDERB, and bit PB_2DDR select the pin function as follows.

OIS3/2 and OS1/0	All 0			Not all 0
PB_2DDR	0	1	1	—
NDER10	—	0	1	—
Pin function	PB_2 input	PB_2 output	TP_{10} output	TMO_2 output

PB_1/TP_9/ $TMIO_1$/ $\overline{DREQ}_0$

Bits OIS3/2 and OS1/0 in 8TCSR1, bits CCLR1 and CCLR0 in 8TCR0, bit NDER9 in NDERB, and bit PB_1DDR select the pin function as follows.

OIS3/2 and OS1/0	All 0			Not all 0
PB_1DDR	0	1	1	—
NDER9	—	0	1	—
Pin function	PB_1 input	PB_1 output	TP_9 output	$TMIO_1$ output
	$TMIO_1$ input*1			
	$\overline{DREQ}_0$ input*2			

Notes: 1. $TMIO_1$ input when CCLR1 = CCLR0 = 1.

2. When an external request is specified as a DMAC activation source, $\overline{DREQ}_0$ input regardless of bits OIS3/2 and OS1/0, bit NDER9, and bit PB_1DDR.

PB_0/TP_8/ TMO_0

Bits OIS3/2 and OS1/0 in 8TCSR0, bit NDER8 in NDERB, and bit PB_0DDR select the pin function as follows.

OIS3/2 and OS1/0	All 0			Not all 0
PB_0DDR	0	1	1	—
NDER8	—	0	1	—
Pin function	PB_0 input	PB_0 output	TP_8 output	TMO_0 output

Section 9 16-Bit Timer

9.1 Overview

The H8/3069R has built-in 16-bit timer module with three 16-bit counter channels.

9.1.1 Features

16-bit timer features are listed below.

- Capability to process up to 6 pulse outputs or 6 pulse inputs
- Six general registers (GRs, two per channel) with independently-assignable output compare or input capture functions
- Selection of eight counter clock sources for each channel:
  Internal clocks: ϕ, $\phi/2$, $\phi/4$, $\phi/8$
  External clocks: TCLKA, TCLKB, TCLKC, TCLKD
- Five operating modes selectable in all channels:
  - Waveform output by compare match
    Selection of 0 output, 1 output, or toggle output (only 0 or 1 output in channel 2)
  - Input capture function
    Rising edge, falling edge, or both edges (selectable)
  - Counter clearing function
    Counters can be cleared by compare match or input capture.
  - Synchronization
    Two or more timer counters (16TCNTs) can be preset simultaneously, or cleared simultaneously by compare match or input capture. Counter synchronization enables synchronous register input and output.
  - PWM mode
    PWM output can be provided with an arbitrary duty cycle. With synchronization, up to three-phase PWM output is possible.
- Phase counting mode selectable in channel 2
  Two-phase encoder output can be counted automatically.
- High-speed access via internal 16-bit bus
  The 16TCNTs and GRs can be accessed at high speed via a 16-bit bus.
- Any initial timer output value can be set
- Nine interrupt sources
  Each channel has two compare match/input capture interrupts and an overflow interrupt. All interrupts can be requested independently.

- Output triggering of programmable timing pattern controller (TPC)
  Compare match/input capture signals from channels 0 to 2 can be used as TPC output triggers.

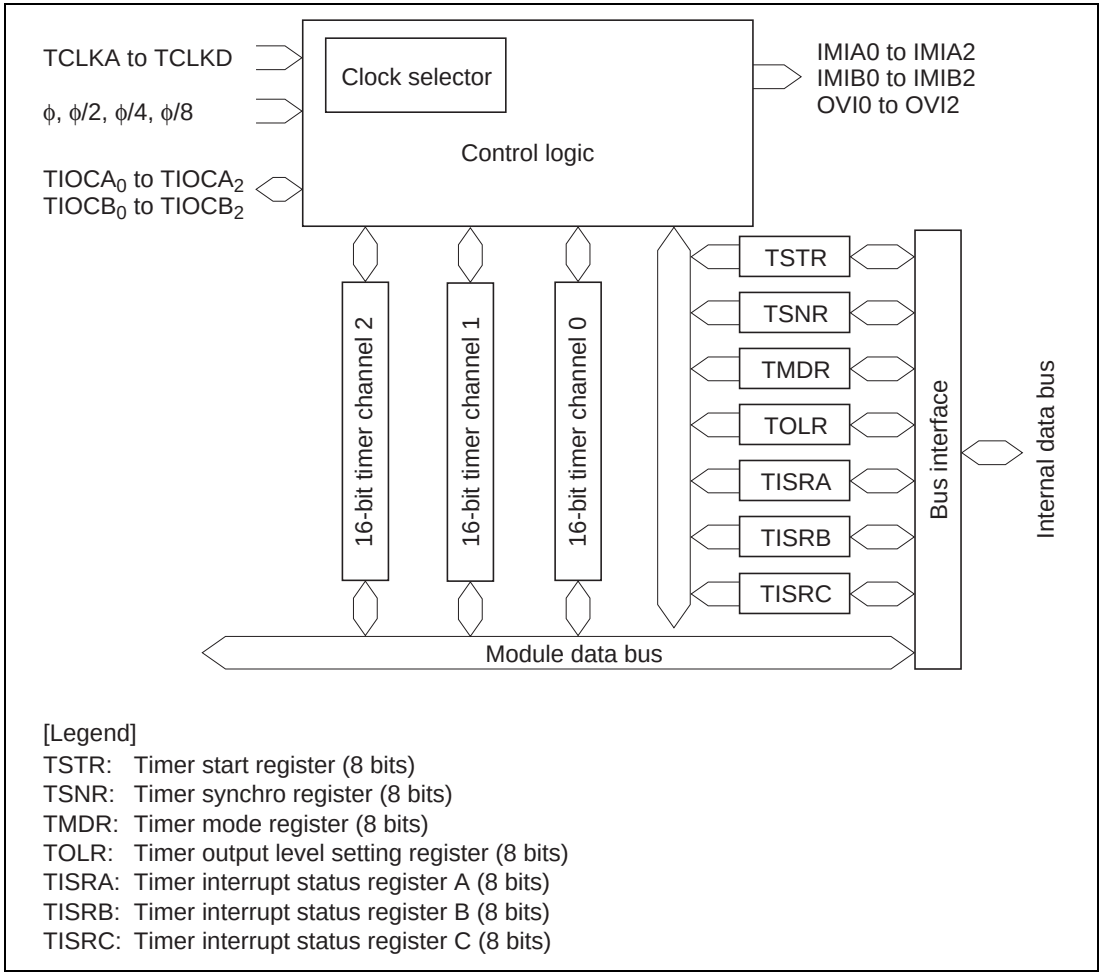
Table 9.1 summarizes the 16-bit timer functions.

Table 9.1 16-bit timer Functions

Item		Channel 0	Channel 1	Channel 2
Clock sources		Internal clocks: ϕ, ϕ/2, ϕ/4, ϕ/8 External clocks: TCLKA, TCLKB, TCLKC, TCLKD, selectable independently		
General registers (output compare/input capture registers)		GRA0, GRB0	GRA1, GRB1	GRA2, GRB2
Input/output pins		$TIOCA_0$, $TIOCB_0$	$TIOCA_1$, $TIOCB_1$	$TIOCA_2$, $TIOCB_2$
Counter clearing function		GRA0/GRB0 compare match or input capture	GRA1/GRB1 compare match or input capture	GRA2/GRB2 compare match or input capture
Initial output value setting function		Available	Available	Available
Compare match output	0	Available	Available	Available
	1	Available	Available	Available
	Toggle	Available	Available	Not available
Input capture function		Available	Available	Available
Synchronization		Available	Available	Available
PWM mode		Available	Available	Available
Phase counting mode		Not available	Not available	Available
Interrupt sources		Three sources • Compare match/input capture A0 • Compare match/input capture B0 • Overflow	Three sources • Compare match/input capture A1 • Compare match/input capture B1 • Overflow	Three sources • Compare match/input capture A2 • Compare match/input capture B2 • Overflow

9.1.2 Block Diagrams

16-bit timer Block Diagram (Overall): Figure 9.1 is a block diagram of the 16-bit timer.



[Legend]
TSTR: Timer start register (8 bits)
TSNR: Timer synchro register (8 bits)
TMDR: Timer mode register (8 bits)
TOLR: Timer output level setting register (8 bits)
TISRA: Timer interrupt status register A (8 bits)
TISRB: Timer interrupt status register B (8 bits)
TISRC: Timer interrupt status register C (8 bits)

Figure 9.1 16-bit timer Block Diagram (Overall)

Block Diagram of Channels 0 and 1: 16-bit timer channels 0 and 1 are functionally identical. Both have the structure shown in figure 9.2.

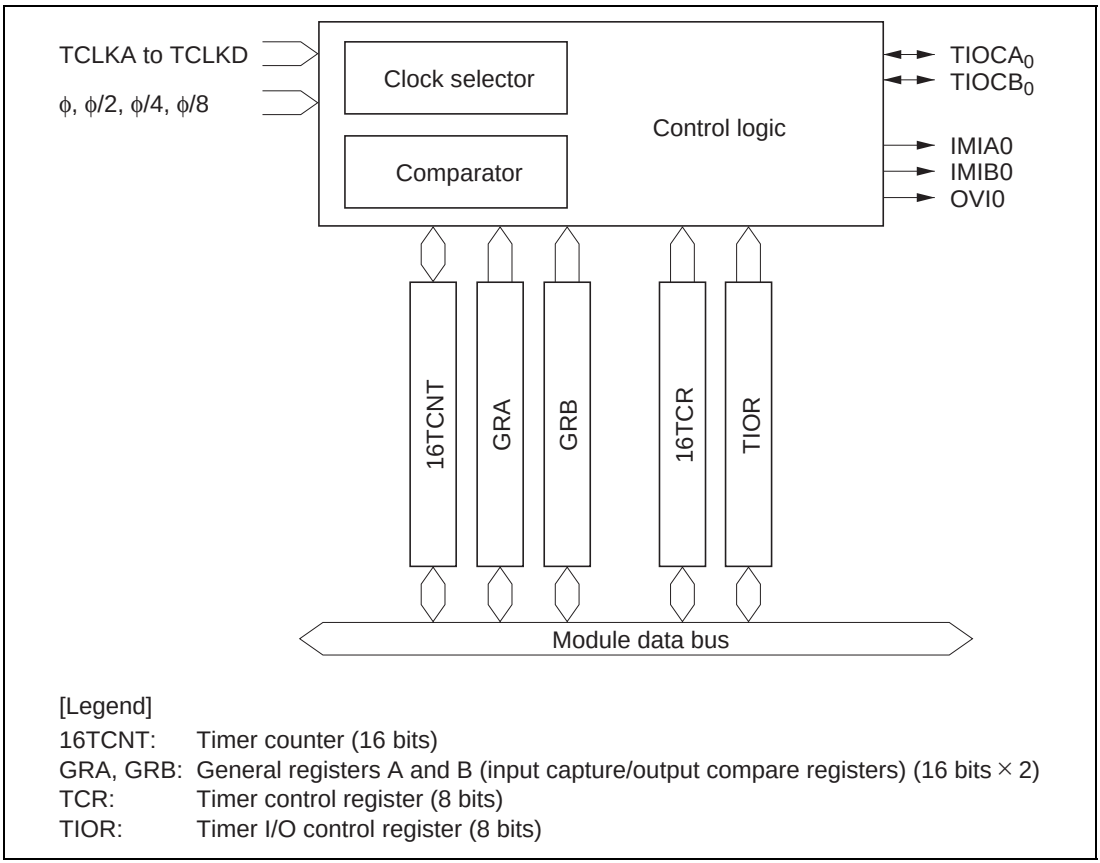
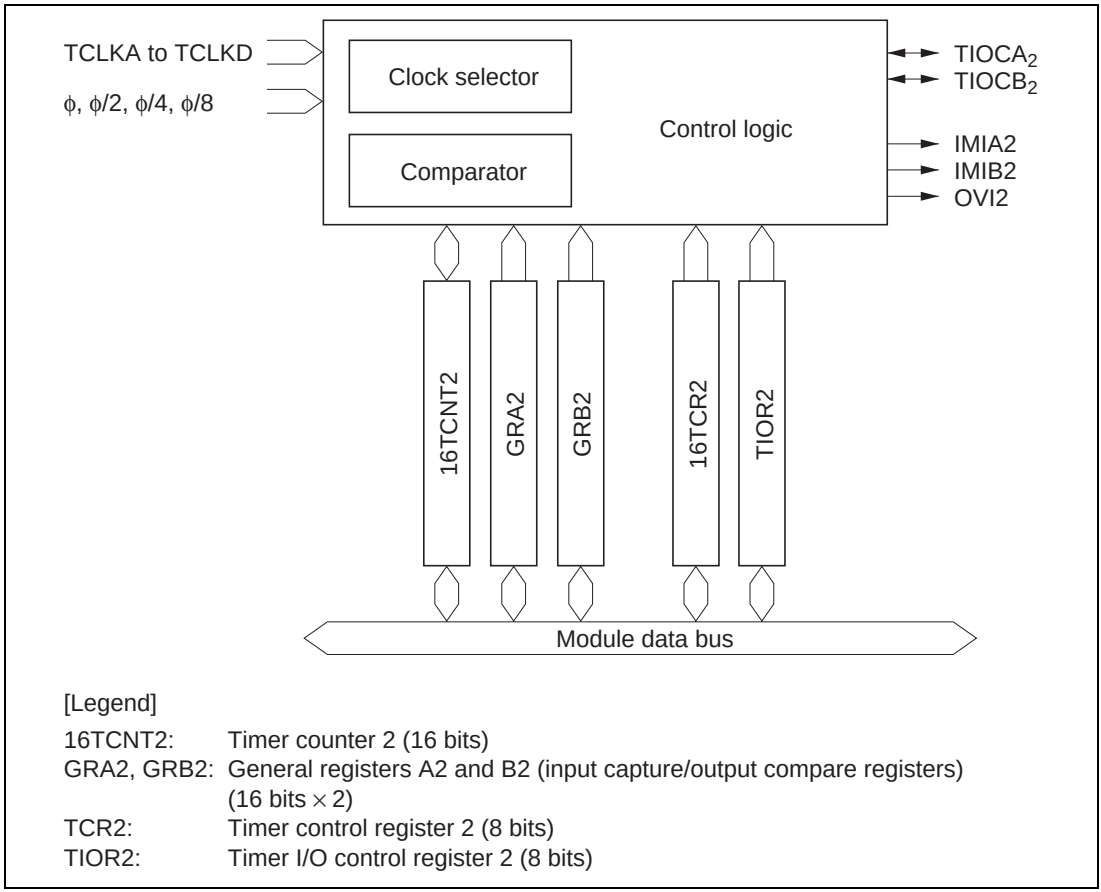


Figure 9.2 Block Diagram of Channels 0 and 1

Block Diagram of Channel 2: Figure 9.3 is a block diagram of channel 2



[Legend]

16TCNT2:	Timer counter 2 (16 bits)
GRA2, GRB2:	General registers A2 and B2 (input capture/output compare registers) (16 bits × 2)
TCR2:	Timer control register 2 (8 bits)
TIOR2:	Timer I/O control register 2 (8 bits)

Figure 9.3 Block Diagram of Channel 2

9.1.3 Pin Configuration

Table 9.2 summarizes the 16-bit timer pins.

Table 9.2 16-bit timer Pins

Channel	Name	Abbre-viation	Input/ Output	Function
Common	Clock input A	TCLKA	Input	External clock A input pin (phase-A input pin in phase counting mode)
	Clock input B	TCLKB	Input	External clock B input pin (phase-B input pin in phase counting mode)
	Clock input C	TCLKC	Input	External clock C input pin
	Clock input D	TCLKD	Input	External clock D input pin
0	Input capture/output compare A0	$TIOCA_0$	Input/ output	GRA0 output compare or input capture pin PWM output pin in PWM mode
	Input capture/output compare B0	$TIOCB_0$	Input/ output	GRB0 output compare or input capture pin
1	Input capture/output compare A1	$TIOCA_1$	Input/ output	GRA1 output compare or input capture pin PWM output pin in PWM mode
	Input capture/output compare B1	$TIOCB_1$	Input/ output	GRB1 output compare or input capture pin
2	Input capture/output compare A2	$TIOCA_2$	Input/ output	GRA2 output compare or input capture pin PWM output pin in PWM mode
	Input capture/output compare B2	$TIOCB_2$	Input/ output	GRB2 output compare or input capture pin

9.1.4 Register Configuration

Table 9.3 summarizes the 16-bit timer registers.

Table 9.3 16-bit timer Registers

Channel	Address*[1]	Name	Abbre-viation	R/W	Initial Value
Common	H'FFF60	Timer start register	TSTR	R/W	H'F8
	H'FFF61	Timer synchro register	TSNC	R/W	H'F8
	H'FFF62	Timer mode register	TMDR	R/W	H'98
	H'FFF63	Timer output level setting register	TOLR	W	H'C0
	H'FFF64	Timer interrupt status register A	TISRA	R/(W)*[2]	H'88
	H'FFF65	Timer interrupt status register B	TISRB	R/(W)*[2]	H'88
	H'FFF66	Timer interrupt status register C	TISRC	R/(W)*[2]	H'88
0	H'FFF68	Timer control register 0	16TCR0	R/W	H'80
	H'FFF69	Timer I/O control register 0	TIOR0	R/W	H'88
	H'FFF6A	Timer counter 0H	16TCNT0H	R/W	H'00
	H'FFF6B	Timer counter 0L	16TCNT0L	R/W	H'00
	H'FFF6C	General register A0H	GRA0H	R/W	H'FF
	H'FFF6D	General register A0L	GRA0L	R/W	H'FF
	H'FFF6E	General register B0H	GRB0H	R/W	H'FF
	H'FFF6F	General register B0L	GRB0L	R/W	H'FF
1	H'FFF70	Timer control register 1	16TCR1	R/W	H'80
	H'FFF71	Timer I/O control register 1	TIOR1	R/W	H'88
	H'FFF72	Timer counter 1H	16TCNT1H	R/W	H'00
	H'FFF73	Timer counter 1L	16TCNT1L	R/W	H'00
	H'FFF74	General register A1H	GRA1H	R/W	H'FF
	H'FFF75	General register A1L	GRA1L	R/W	H'FF
	H'FFF76	General register B1H	GRB1H	R/W	H'FF
	H'FFF77	General register B1L	GRB1L	R/W	H'FF

Channel	Address*[1]	Name	Abbre-viation	R/W	Initial Value
2	H'FFF78	Timer control register 2	16TCR2	R/W	H'80
	H'FFF79	Timer I/O control register 2	TIOR2	R/W	H'88
	H'FFF7A	Timer counter 2H	16TCNT2H	R/W	H'00
	H'FFF7B	Timer counter 2L	16TCNT2L	R/W	H'00
	H'FFF7C	General register A2H	GRA2H	R/W	H'FF
	H'FFF7D	General register A2L	GRA2L	R/W	H'FF
	H'FFF7E	General register B2H	GRB2H	R/W	H'FF
	H'FFF7F	General register B2L	GRB2L	R/W	H'FF

Notes: 1. The lower 20 bits of the address in advanced mode are indicated.
2. Only 0 can be written in bits 3 to 0, to clear the flags.

9.2 Register Descriptions

9.2.1 Timer Start Register (TSTR)

TSTR is an 8-bit readable/writable register that starts and stops the timer counter (16TCNT) in channels 0 to 2.

Bit	7	6	5	4	3	2	1	0
	—	—	—	—	—	STR2	STR1	STR0
Initial value	1	1	1	1	1	0	0	0
Read/Write	—	—	—	—	—	R/W	R/W	R/W

Reserved bits

Counter start 2 to 0
These bits start and stop 16TCNT2 to 16TCNT0

TSTR is initialized to H'F8 by a reset and in standby mode.

Bits 7 to 3—Reserved: These bits cannot be modified and are always read as 1.

Bit 2—Counter Start 2 (STR2): Starts and stops timer counter 2 (16TCNT2).

Bit 2 STR2	Description	
0	16TCNT2 is halted	(Initial value)
1	16TCNT2 is counting	

Bit 1—Counter Start 1 (STR1): Starts and stops timer counter 1 (16TCNT1).

Bit 1 STR1	Description	
0	16TCNT1 is halted	(Initial value)
1	16TCNT1 is counting	

Bit 0—Counter Start 0 (STR0): Starts and stops timer counter 0 (16TCNT0).

Bit 0 STR0	Description	
0	16TCNT0 is halted	(Initial value)
1	16TCNT0 is counting	

9.2.2 Timer Synchro Register (TSNC)

TSNC is an 8-bit readable/writable register that selects whether channels 0 to 2 operate independently or synchronously. Channels are synchronized by setting the corresponding bits to 1.

Bit	7	6	5	4	3	2	1	0
	—	—	—	—	—	SYNC2	SYNC1	SYNC0
Initial value	1	1	1	1	1	0	0	0
Read/Write	—	—	—	—	—	R/W	R/W	R/W

Reserved bits

Timer sync 2 to 0
These bits synchronize channels 2 to 0

TSNC is initialized to H'F8 by a reset and in standby mode.

Bits 7 to 3—Reserved: These bits cannot be modified and are always read as 1.

Bit 2—Timer Sync 2 (SYNC2): Selects whether channel 2 operates independently or synchronously.

Bit 2 SYNC2	Description	
0	Channel 2's timer counter (16TCNT2) operates independently 16TCNT2 is preset and cleared independently of other channels	(Initial value)
1	Channel 2 operates synchronously 16TCNT2 can be synchronously preset and cleared	

Bit 1—Timer Sync 1 (SYNC1): Selects whether channel 1 operates independently or synchronously.

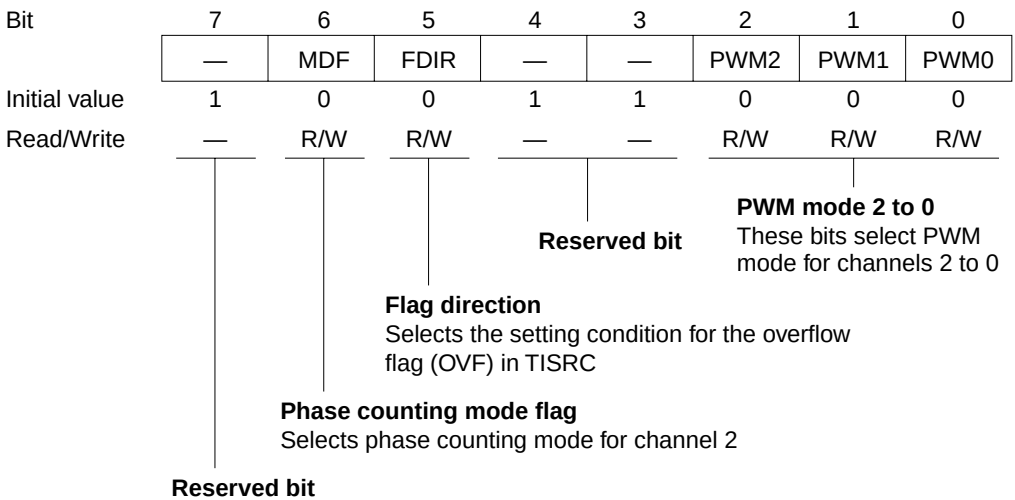
Bit 1 SYNC1	Description	
0	Channel 1's timer counter (16TCNT1) operates independently 16TCNT1 is preset and cleared independently of other channels	(Initial value)
1	Channel 1 operates synchronously 16TCNT1 can be synchronously preset and cleared	

Bit 0—Timer Sync 0 (SYNC0): Selects whether channel 0 operates independently or synchronously.

Bit 0 SYNC0	Description	
0	Channel 0's timer counter (16TCNT0) operates independently 16TCNT0 is preset and cleared independently of other channels	(Initial value)
1	Channel 0 operates synchronously 16TCNT0 can be synchronously preset and cleared	

9.2.3 Timer Mode Register (TMDR)

TMDR is an 8-bit readable/writable register that selects PWM mode for channels 0 to 2. It also selects phase counting mode and the overflow flag (OVF) setting conditions for channel 2.



TMDR is initialized to H'98 by a reset and in standby mode.

Bit 7—Reserved: This bit cannot be modified and is always read as 1.

Bit 6—Phase Counting Mode Flag (MDF): Selects whether channel 2 operates normally or in phase counting mode.

Bit 6 MDF	Description	
0	Channel 2 operates normally	(Initial value)
1	Channel 2 operates in phase counting mode	

When MDF is set to 1 to select phase counting mode, 16TCNT2 operates as an up/down-counter and pins TCLKA and TCLKB become counter clock input pins. 16TCNT2 counts both rising and falling edges of TCLKA and TCLKB, and counts up or down as follows.

Counting Direction	Down-Counting				Up-Counting			
TCLKA pin	↑	High	↓	Low	Low	↑	High	↓
TCLKB pin	Low	↑	High	↓	↑	High	↓	Low

In phase counting mode, external clock edge selection by bits CKEG1 and CKEG0 in 16TCR2 and counter clock selection by bits TPSC2 to TPSC0 are invalid, and the above phase counting mode operations take precedence.

The counter clearing condition selected by the CCLR1 and CCLR0 bits in 16TCR2 and the compare match/input capture settings and interrupt functions of TIOR2, TISRA, TISRB, TISRC remain effective in phase counting mode.

Bit 5—Flag Direction (FDIR): Designates the setting condition for the OVF flag in TISRC. The FDIR designation is valid in all modes in channel 2.

Bit 5 FDIR	Description	
0	OVF is set to 1 in TISRC when 16TCNT2 overflows or underflows	(Initial value)
1	OVF is set to 1 in TISRC when 16TCNT2 overflows	

Bits 4 and 3—Reserved: These bits cannot be modified and are always read as 1.

Bit 2—PWM Mode 2 (PWM2): Selects whether channel 2 operates normally or in PWM mode.

Bit 2 PWM2	Description	
0	Channel 2 operates normally	(Initial value)
1	Channel 2 operates in PWM mode	

When bit PWM2 is set to 1 to select PWM mode, pin $TIOCA_2$ becomes a PWM output pin. The output goes to 1 at compare match with GRA2, and to 0 at compare match with GRB2.

Bit 1—PWM Mode 1 (PWM1): Selects whether channel 1 operates normally or in PWM mode.

Bit 1 PWM1	Description	
0	Channel 1 operates normally	(Initial value)
1	Channel 1 operates in PWM mode	

When bit PWM1 is set to 1 to select PWM mode, pin $TIOCA_1$ becomes a PWM output pin. The output goes to 1 at compare match with GRA1, and to 0 at compare match with GRB1.

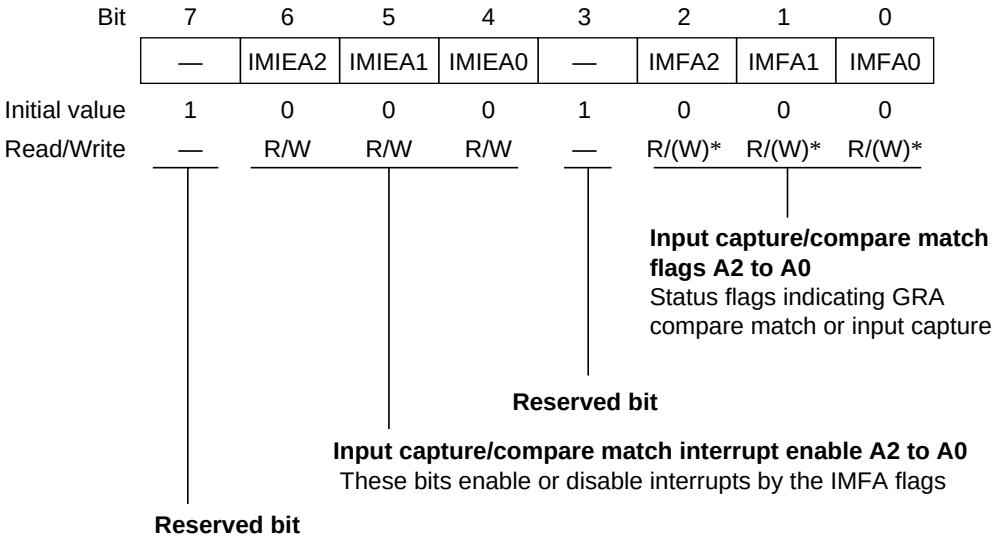
Bit 0—PWM Mode 0 (PWM0): Selects whether channel 0 operates normally or in PWM mode.

Bit 0 PWM0	Description	
0	Channel 0 operates normally	(Initial value)
1	Channel 0 operates in PWM mode	

When bit PWM0 is set to 1 to select PWM mode, pin $TIOCA_0$ becomes a PWM output pin. The output goes to 1 at compare match with GRA0, and to 0 at compare match with GRB0.

9.2.4 Timer Interrupt Status Register A (TISRA)

TISRA is an 8-bit readable/writable register that indicates GRA compare match or input capture and enables or disables GRA compare match and input capture interrupt requests.



Note: * Only 0 can be written, to clear the flag.

TISRA is initialized to H'88 by a reset and in standby mode.

Bit 7—Reserved: This bit cannot be modified and is always read as 1.

Bit 6—Input Capture/Compare Match Interrupt Enable A2 (IMIEA2): Enables or disables the interrupt requested by the IMFA2 when IMFA2 flag is set to 1.

Bit 6 IMIEA2	Description	
0	IMIA2 interrupt requested by IMFA2 flag is disabled	(Initial value)
1	IMIA2 interrupt requested by IMFA2 flag is enabled	

Bit 5—Input Capture/Compare Match Interrupt Enable A1 (IMIEA1): Enables or disables the interrupt requested by the IMFA1 flag when IMFA1 is set to 1.

Bit 5 IMIEA1	Description	
0	IMIA1 interrupt requested by IMFA1 flag is disabled	(Initial value)
1	IMIA1 interrupt requested by IMFA1 flag is enabled	

Bit 4—Input Capture/Compare Match Interrupt Enable A0 (IMIEA0): Enables or disables the interrupt requested by the IMFA0 flag when IMFA0 is set to 1.

Bit 4 IMIEA0	Description	
0	IMIA0 interrupt requested by IMFA0 flag is disabled	(Initial value)
1	IMIA0 interrupt requested by IMFA0 flag is enabled	

Bit 3—Reserved: This bit cannot be modified and is always read as 1.

Bit 2—Input Capture/Compare Match Flag A2 (IMFA2): This status flag indicates GRA2 compare match or input capture events.

Bit 2 IMFA2	Description	
0	[Clearing condition] Read IMFA2 flag when IMFA2 =1, then write 0 in IMFA2 flag	(Initial value)
1	[Setting conditions] • 16TCNT2 = GRA2 when GRA2 functions as an output compare register • 16TCNT2 value is transferred to GRA2 by an input capture signal when GRA2 functions as an input capture register	

Bit 1—Input Capture/Compare Match Flag A1 (IMFA1): This status flag indicates GRA1 compare match or input capture events.

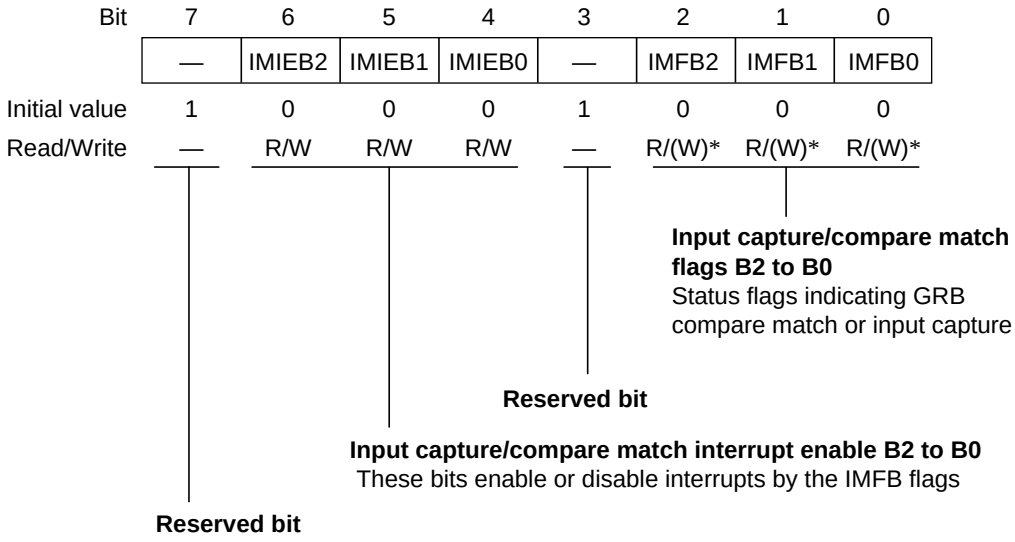
Bit 1 IMFA1	Description	
0	[Clearing condition]	(Initial value)
	Read IMFA1 flag when IMFA1 =1, then write 0 in IMFA1 flag	
1	[Setting conditions]	
	• 16TCNT1 = GRA1 when GRA1 functions as an output compare register	
	• 16TCNT1 value is transferred to GRA1 by an input capture signal when GRA1 functions as an input capture register	

Bit 0—Input Capture/Compare Match Flag A0 (IMFA0): This status flag indicates GRA0 compare match or input capture events.

Bit 0 IMFA0	Description	
0	[Clearing condition]	(Initial value)
	Read IMFA0 flag when IMFA0 =1, then write 0 in IMFA0 flag	
1	[Setting conditions]	
	• 16TCNT0 = GRA0 when GRA0 functions as an output compare register	
	• 16TCNT0 value is transferred to GRA0 by an input capture signal when GRA0 functions as an input capture register	

9.2.5 Timer Interrupt Status Register B (TISRB)

TISRB is an 8-bit readable/writable register that indicates GRB compare match or input capture and enables or disables GRB compare match and input capture interrupt requests.



Note: * Only 0 can be written, to clear the flag.

TISRB is initialized to H'88 by a reset and in standby mode.

Bit 7—Reserved: This bit cannot be modified and is always read as 1.

Bit 6—Input Capture/Compare Match Interrupt Enable B2 (IMIEB2): Enables or disables the interrupt requested by the IMFB2 when IMFB2 flag is set to 1.

Bit 6 IMIEB2	Description	
0	IMIB2 interrupt requested by IMFB2 flag is disabled	(Initial value)
1	IMIB2 interrupt requested by IMFB2 flag is enabled	

Bit 5—Input Capture/Compare Match Interrupt Enable B1 (IMIEB1): Enables or disables the interrupt requested by the IMFB1 when IMFB1 flag is set to 1.

Bit 5 IMIEB1	Description	
0	IMIB1 interrupt requested by IMFB1 flag is disabled	(Initial value)
1	IMIB1 interrupt requested by IMFB1 flag is enabled	

Bit 4—Input Capture/Compare Match Interrupt Enable B0 (IMIEB0): Enables or disables the interrupt requested by the IMFB0 when IMFB0 flag is set to 1.

Bit 4 IMIEB0	Description	
0	IMIB0 interrupt requested by IMFB0 flag is disabled	(Initial value)
1	IMIB0 interrupt requested by IMFB0 flag is enabled	

Bit 3—Reserved: This bit cannot be modified and is always read as 1.

Bit 2—Input Capture/Compare Match Flag B2 (IMFB2): This status flag indicates GRB2 compare match or input capture events.

Bit 2 IMFB2	Description	
0	[Clearing condition] Read IMFB2 flag when IMFB2 =1, then write 0 in IMFB2 flag	(Initial value)
1	[Setting conditions] • 16TCNT2 = GRB2 when GRB2 functions as an output compare register • 16TCNT2 value is transferred to GRB2 by an input capture signal when GRB2 functions as an input capture register	

Bit 1—Input Capture/Compare Match Flag B1 (IMFB1): This status flag indicates GRB1 compare match or input capture events.

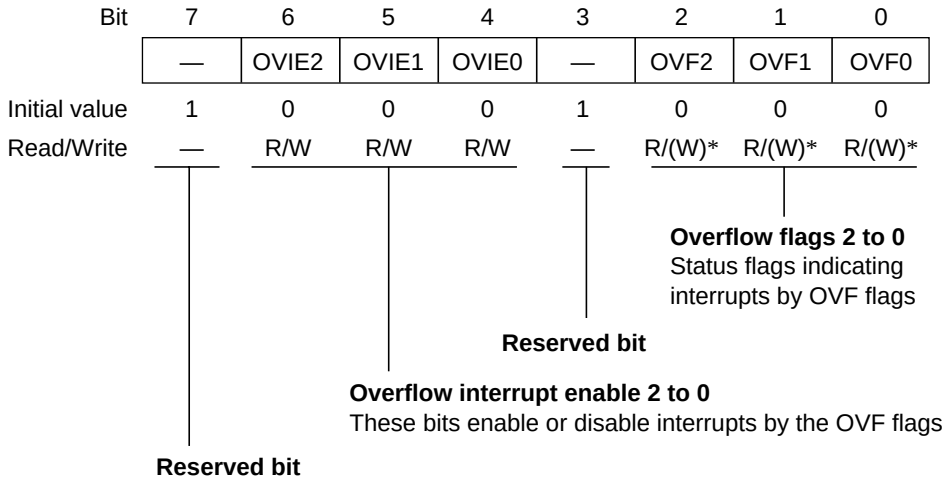
Bit 1 IMFB1	Description	
0	[Clearing condition]	(Initial value)
	Read IMFB1 flag when IMFB1 =1, then write 0 in IMFB1 flag	
1	[Setting conditions]	
	• 16TCNT1 = GRB1 when GRB1 functions as an output compare register	
	• 16TCNT1 value is transferred to GRB1 by an input capture signal when GRB1 functions as an input capture register	

Bit 0—Input Capture/Compare Match Flag B0 (IMFB0): This status flag indicates GRB0 compare match or input capture events.

Bit 0 IMFB0	Description	
0	[Clearing condition]	(Initial value)
	Read IMFB0 flag when IMFB0 =1, then write 0 in IMFB0 flag	
1	[Setting conditions]	
	• 16TCNT0 = GRB0 when GRB0 functions as an output compare register	
	• 16TCNT0 value is transferred to GRB0 by an input capture signal when GRB0 functions as an input capture register	

9.2.6 Timer Interrupt Status Register C (TISRC)

TISRC is an 8-bit readable/writable register that indicates 16TCNT overflow or underflow and enables or disables overflow interrupt requests.



Note: * Only 0 can be written, to clear the flag.

TISRC is initialized to H'88 by a reset and in standby mode.

Bit 7—Reserved: This bit cannot be modified and is always read as 1.

Bit 6—Overflow Interrupt Enable 2 (OVIE2): Enables or disables the interrupt requested by the OVF2 when OVF2 flag is set to 1.

Bit 6 OVIE2	Description	
0	OVI2 interrupt requested by OVF2 flag is disabled	(Initial value)
1	OVI2 interrupt requested by OVF2 flag is enabled	

Bit 5—Overflow Interrupt Enable 1 (OVIE1): Enables or disables the interrupt requested by the OVF1 when OVF1 flag is set to 1.

Bit 5 OVIE1	Description	
0	OVI1 interrupt requested by OVF1 flag is disabled	(Initial value)
1	OVI1 interrupt requested by OVF1 flag is enabled	

Bit 4—Overflow Interrupt Enable 0 (OVIE0): Enables or disables the interrupt requested by the OVF0 when OVF0 flag is set to 1.

Bit 4 OVIE0	Description	
0	OVI0 interrupt requested by OVF0 flag is disabled	(Initial value)
1	OVI0 interrupt requested by OVF0 flag is enabled	

Bit 3—Reserved: This bit cannot be modified and is always read as 1.

Bit 2—Overflow Flag 2 (OVF2): This status flag indicates 16TCNT2 overflow.

Bit 2 OVF2	Description	
0	[Clearing condition] Read OVF2 flag when OVF2 =1, then write 0 in OVF2 flag	(Initial value)
1	[Setting condition] 16TCNT2 overflowed from H'FFFF to H'0000, or underflowed from H'0000 to H'FFFF	

Note: 16TCNT underflow occurs when 16TCNT operates as an up/down-counter. Underflow occurs only when channel 2 operates in phase counting mode (MDF = 1 in TMDR).

Bit 1—Overflow Flag 1 (OVF1): This status flag indicates 16TCNT1 overflow.

Bit 1 OVF1	Description	
0	[Clearing condition] Read OVF1 flag when OVF1 =1, then write 0 in OVF1 flag	(Initial value)
1	[Setting condition] 16TCNT1 overflowed from H'FFFF to H'0000	

Bit 0—Overflow Flag 0 (OVF0): This status flag indicates 16TCNT0 overflow.

Bit 0 OVF0	Description	
0	[Clearing condition] Read OVF0 flag when OVF0 =1, then write 0 in OVF0 flag	(Initial value)
1	[Setting condition] 16TCNT0 overflowed from H'FFFF to H'0000	

9.2.7 Timer Counters (16TCNT)

16TCNT is a 16-bit counter. The 16-bit timer has three 16TCNTs, one for each channel.

Channel	Abbreviation	Function
0	16TCNT0	Up-counter
1	16TCNT1	
2	16TCNT2	Phase counting mode: up/down-counter Other modes: up-counter

Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Initial value	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Each 16TCNT is a 16-bit readable/writable register that counts pulse inputs from a clock source. The clock source is selected by bits TPSC2 to TPSC0 in 16TCR.

16TCNT0 and 16TCNT1 are up-counters. 16TCNT2 is an up/down-counter in phase counting mode and an up-counter in other modes.

16TCNT can be cleared to H'0000 by compare match with GRA or GRB or by input capture to GRA or GRB (counter clearing function).

When 16TCNT overflows (changes from H'FFFF to H'0000), the OVF flag is set to 1 in TISRC of the corresponding channel.

When 16TCNT underflows (changes from H'0000 to H'FFFF), the OVF flag is set to 1 in TISRC of the corresponding channel.

The 16TCNTs are linked to the CPU by an internal 16-bit bus and can be written or read by either word access or byte access.

Each 16TCNT is initialized to H'0000 by a reset and in standby mode.

9.2.8 General Registers (GRA, GRB)

The general registers are 16-bit registers. The 16-bit timer has 6 general registers, two in each channel.

Channel	Abbreviation	Function
0	GRA0, GRB0	Output compare/input capture register
1	GRA1, GRB1	
2	GRA2, GRB2	

Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Initial value	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

A general register is a 16-bit readable/writable register that can function as either an output compare register or an input capture register. The function is selected by settings in TIOR.

When a general register is used as an output compare register, its value is constantly compared with the 16TCNT value. When the two values match (compare match), the IMFA or IMFB flag is set to 1 in TISRA/TISRB. Compare match output can be selected in TIOR.

When a general register is used as an input capture register, an external input capture signal are detected and the current 16TCNT value is stored in the general register. The corresponding IMFA or IMFB flag in TISRA/TISRB is set to 1 at the same time. The edges of the input capture signal are selected in TIOR.

TIOR settings are ignored in PWM mode.

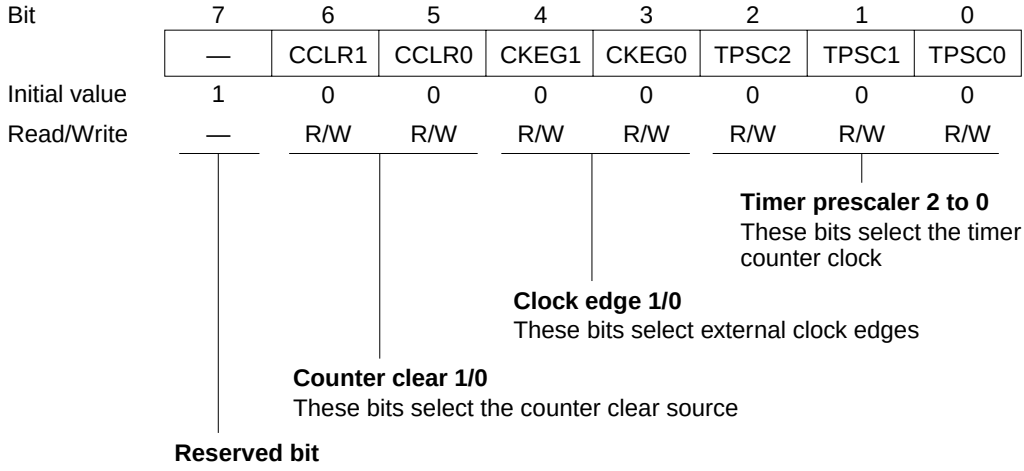
General registers are linked to the CPU by an internal 16-bit bus and can be written or read by either word access or byte access.

General registers are set as output compare registers (with no pin output) and initialized to H'FFFF by a reset and in standby mode.

9.2.9 Timer Control Registers (16TCR)

16TCR is an 8-bit register. The 16-bit timer has three 16TCRs, one in each channel.

Channel	Abbreviation	Function
0	16TCR0	16TCR controls the timer counter. The 16TCRs in all channels are functionally identical. When phase counting mode is selected in channel 2, the settings of bits CKEG1 and CKEG0 and TPSC2 to TPSC0 in 16TCR2 are ignored.
1	16TCR1	
2	16TCR2	



Each 16TCR is an 8-bit readable/writable register that selects the timer counter clock source, selects the edge or edges of external clock sources, and selects how the counter is cleared.

16TCR is initialized to H'80 by a reset and in standby mode.

Bit 7—Reserved: This bit cannot be modified and is always read as 1.

Bits 6 and 5—Counter Clear 1 and 0 (CCLR1, CCLR0): These bits select how 16TCNT is cleared.

Bit 6 CCLR1	Bit 5 CCLR0	Description	
0	0	16TCNT is not cleared	(Initial value)
	1	16TCNT is cleared by GRA compare match or input capture*[1]	
1	0	16TCNT is cleared by GRB compare match or input capture*[1]	
	1	Synchronous clear: 16TCNT is cleared in synchronization with other synchronized timers*[2]	

Notes: 1. 16TCNT is cleared by compare match when the general register functions as an output compare register, and by input capture when the general register functions as an input capture register.
2. Selected in TSNC.

Bits 4 and 3—Clock Edge 1 and 0 (CKEG1, CKEG0): These bits select external clock input edges when an external clock source is used.

Bit 4 CKEG1	Bit 3 CKEG0	Description	
0	0	Count rising edges	(Initial value)
	1	Count falling edges	
1	—	Count both edges	

When channel 2 is set to phase counting mode, bits CKEG1 and CKEG0 in 16TCR2 are ignored. Phase counting takes precedence.

Bits 2 to 0—Timer Prescaler 2 to 0 (TPSC2 to TPSC0): These bits select the counter clock of 16TCNT.

Bit 2 TPSC2	Bit 1 TPSC1	Bit 0 TPSC0	Function	
0	0	0	Internal clock: ϕ	(Initial value)
		1	Internal clock: $\phi/2$	
	1	0	Internal clock: $\phi/4$	
		1	Internal clock: $\phi/8$	
1	0	0	External clock A: TCLKA input	
		1	External clock B: TCLKB input	
	1	0	External clock C: TCLKC input	
		1	External clock D: TCLKD input	

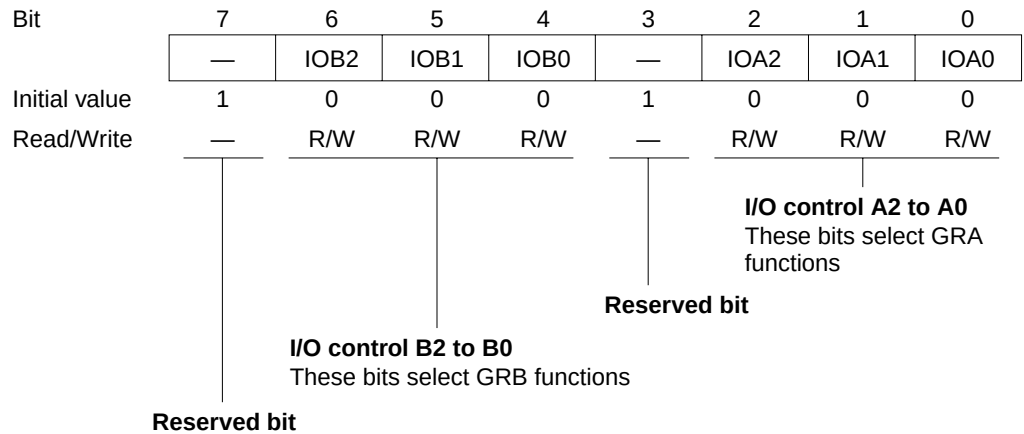
When bit TPSC2 is cleared to 0 an internal clock source is selected, and the timer counts only falling edges. When bit TPSC2 is set to 1 an external clock source is selected, and the timer counts the edges selected by bits CKEG1 and CKEG0.

When channel 2 is set to phase counting mode (MDF = 1 in TMDR), the settings of bits TPSC2 to TPSC0 in 16TCR2 are ignored. Phase counting takes precedence.

9.2.10 Timer I/O Control Register (TIOR)

TIOR is an 8-bit register. The 16-bit timer has three TIORs, one in each channel.

Channel	Abbreviation	Function
0	TIOR0	TIOR controls the general registers. Some functions differ in PWM mode.
1	TIOR1	
2	TIOR2	



Each TIOR is an 8-bit readable/writable register that selects the output compare or input capture function for GRA and GRB, and specifies the functions of the TIORA and TIORB pins. If the output compare function is selected, TIOR also selects the type of output. If input capture is selected, TIOR also selects the edges of the input capture signal.

TIOR is initialized to H'88 by a reset and in standby mode.

Bit 7—Reserved: This bit cannot be modified and is always read as 1.

Bits 6 to 4—I/O Control B2 to B0 (IOB2 to IOB0): These bits select the GRB function.

Bit 6 IOB2	Bit 5 IOB1	Bit 4 IOB0	Function	
0	0	0	GRB is an output compare register	No output at compare match (Initial value)
		1		0 output at GRB compare match*[1]
	1	0		1 output at GRB compare match*[1]
		1		Output toggles at GRB compare match (1 output in channel 2)*[1] *[2]
1	0	0	GRB is an input compare register	GRB captures rising edge of input
		1		GRB captures falling edge of input
	1	0		GRB captures both edges of input
		1		

Notes: 1. After a reset, the output conforms to the TOLR setting until the first compare match.
2. Channel 2 output cannot be toggled by compare match. When this setting is made, 1 output is selected automatically.

Bit 3—Reserved: This bit cannot be modified and is always read as 1.

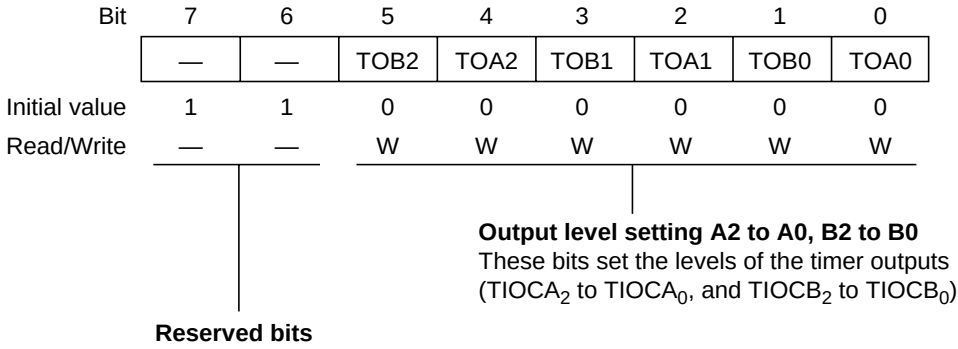
Bits 2 to 0—I/O Control A2 to A0 (IOA2 to IOA0): These bits select the GRA function.

Bit 2 IOA2	Bit 1 IOA1	Bit 0 IOA0	Function	
0	0	0	GRA is an output compare register	No output at compare match (Initial value)
		1		0 output at GRA compare match*[1]
	1	0		1 output at GRA compare match*[1]
		1		Output toggles at GRA compare match (1 output in channel 2)*[1] *[2]
1	0	0	GRA is an input compare register	GRA captures rising edge of input
		1		GRA captures falling edge of input
	1	0		GRA captures both edges of input
		1		

Notes: 1. After a reset, the output conforms to the TOLR setting until the first compare match.
2. Channel 2 output cannot be toggled by compare match. When this setting is made, 1 output is selected automatically.

9.2.11 Timer Output Level Setting Register C (TOLR)

TOLR is an 8-bit write-only register that selects the timer output level for channels 0 to 2.



A TOLR setting can only be made when the corresponding bit in TSTR is 0.

TOLR is a write-only register, and cannot be read. If it is read, all bits will return a value of 1.

TOLR is initialized to H'C0 by a reset and in standby mode.

Bits 7 and 6—Reserved: These bits cannot be modified.

Bit 5—Output Level Setting B2 (TOB2): Sets the value of timer output $TIOCB_2$.

Bit 5 TOB2	Description	
0	$TIOCB_2$ is 0	(Initial value)
1	$TIOCB_2$ is 1	

Bit 4—Output Level Setting A2 (TOA2): Sets the value of timer output $TIOCA_2$.

Bit 4 TOA2	Description	
0	$TIOCA_2$ is 0	(Initial value)
1	$TIOCA_2$ is 1	

Bit 3—Output Level Setting B1 (TOB1): Sets the value of timer output $TIOCB_1$.

Bit 3 TOB1	Description	
0	$TIOCB_1$ is 0	(Initial value)
1	$TIOCB_1$ is 1	

Bit 2—Output Level Setting A1 (TOA1): Sets the value of timer output $TIOCA_1$.

Bit 2 TOA1	Description	
0	$TIOCA_1$ is 0	(Initial value)
1	$TIOCA_1$ is 1	

Bit 1—Output Level Setting B0 (TOB0): Sets the value of timer output $TIOCB_0$.

Bit 0 TOB0	Description	
0	$TIOCB_0$ is 0	(Initial value)
1	$TIOCB_0$ is 1	

Bit 0—Output Level Setting A0 (TOA0): Sets the value of timer output $TIOCA_0$.

Bit 0 TOA0	Description	
0	$TIOCA_0$ is 0	(Initial value)
1	$TIOCA_0$ is 1	

9.3 CPU Interface

9.3.1 16-Bit Accessible Registers

The timer counters (16TCNTs), general registers A and B (GRAs and GRBs) are 16-bit registers, and are linked to the CPU by an internal 16-bit data bus. These registers can be written or read a word at a time, or a byte at a time.

Figures 9.4 and 9.5 show examples of word read/write access to a timer counter (16TCNT). Figures 9.6 to 9.9 show examples of byte read/write access to 16TCNTH and 16TCNTL.

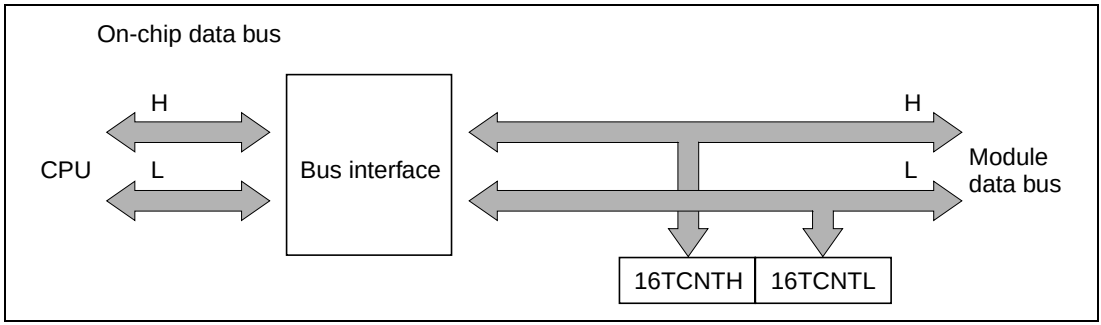


Figure 9.4 16TCNT Access Operation [CPU Writes to 16TCNT, Word]

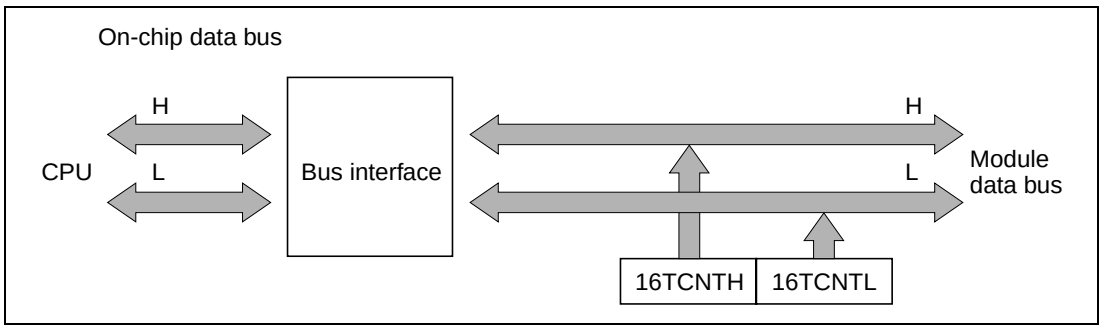


Figure 9.5 Access to Timer Counter (CPU Reads 16TCNT, Word)

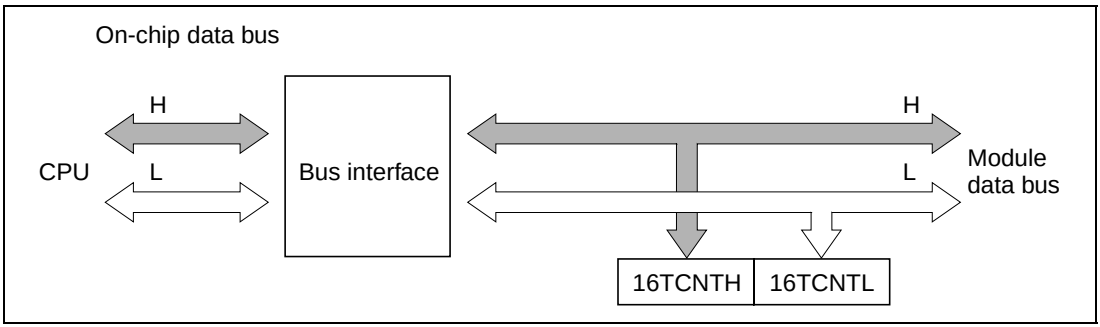


Figure 9.6 Access to Timer Counter H (CPU Writes to 16TCNTH, Upper Byte)

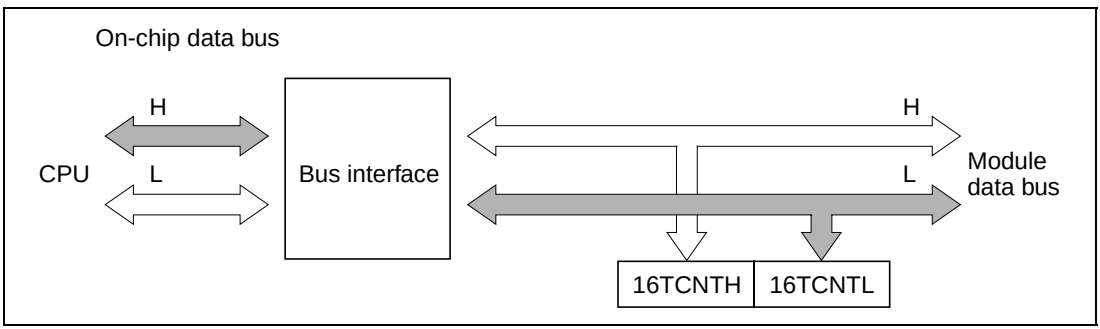


Figure 9.7 Access to Timer Counter L (CPU Writes to 16TCNTL, Lower Byte)

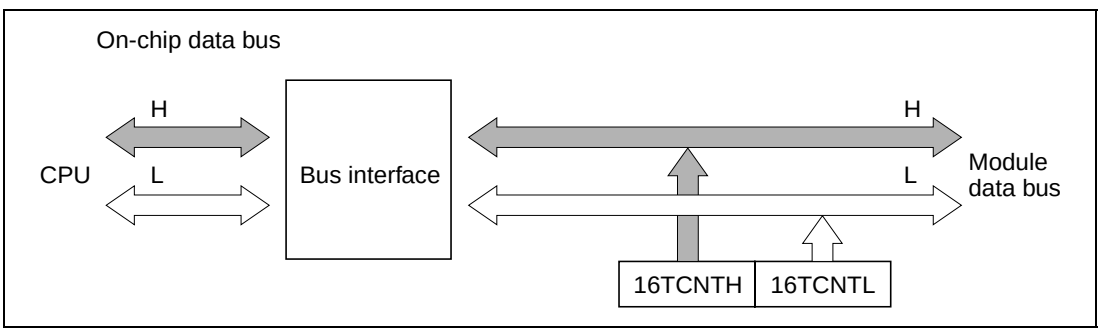


Figure 9.8 Access to Timer Counter H (CPU Reads 16TCNTH, Upper Byte)

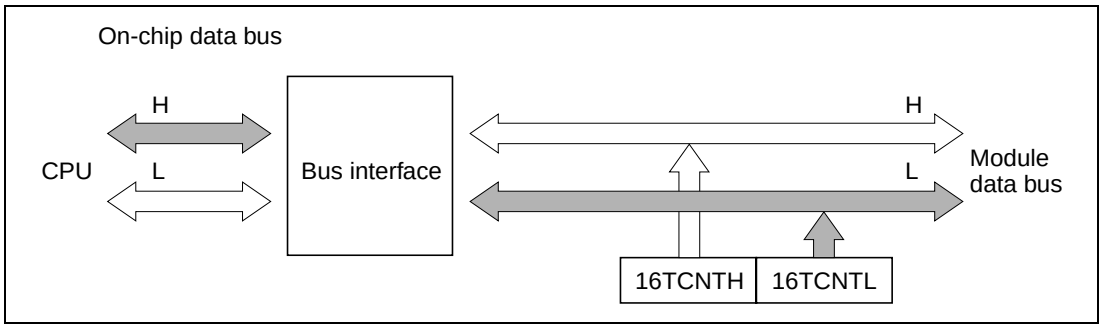


Figure 9.9 Access to Timer Counter L (CPU Reads 16TCNTL, Lower Byte)

9.3.2 8-Bit Accessible Registers

The registers other than the timer counters and general registers are 8-bit registers. These registers are linked to the CPU by an internal 8-bit data bus.

Figures 9.10 and 9.11 show examples of byte read and write access to a 16TCR.

If a word-size data transfer instruction is executed, two byte transfers are performed.

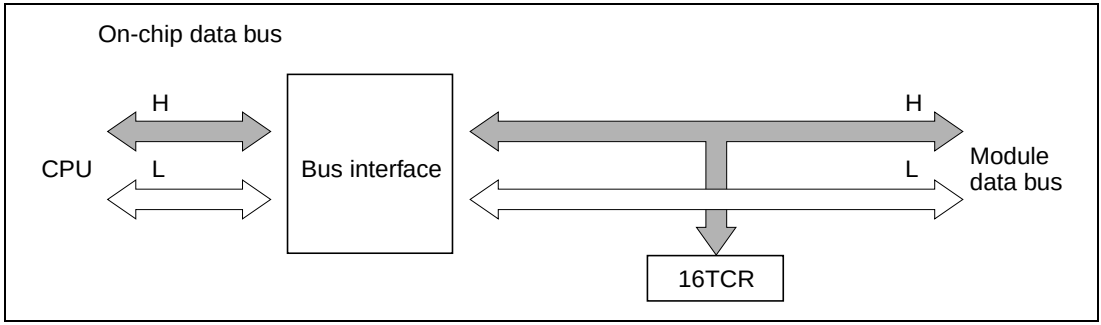


Figure 9.10 16TCR Access (CPU Writes to 16TCR)

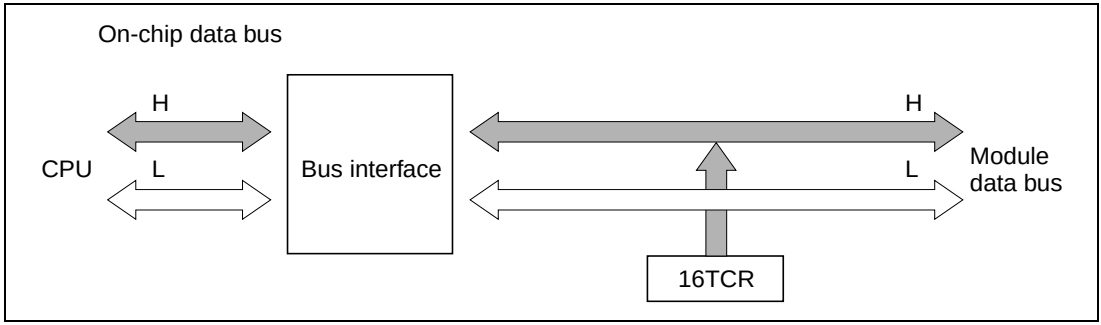


Figure 9.11 16TCR Access (CPU Reads 16TCR)

9.4 Operation

9.4.1 Overview

A summary of operations in the various modes is given below.

Normal Operation: Each channel has a timer counter and general registers. The timer counter counts up, and can operate as a free-running counter, periodic counter, or external event counter. GRA and GRB can be used for input capture or output compare.

Synchronous Operation: The timer counters in designated channels are preset synchronously. Data written to the timer counter in any one of these channels is simultaneously written to the timer counters in the other channels as well. The timer counters can also be cleared synchronously if so designated by the CCLR1 and CCLR0 bits in the TCRs.

PWM Mode: A PWM waveform is output from the TIOCA pin. The output goes to 1 at compare match A and to 0 at compare match B. The duty cycle can be varied from 0% to 100% depending on the settings of GRA and GRB. When a channel is set to PWM mode, its GRA and GRB automatically become output compare registers.

Phase Counting Mode: The phase relationship between two clock signals input at TCLKA and TCLKB is detected and 16TCNT2 counts up or down accordingly. When phase counting mode is selected TCLKA and TCLKB become clock input pins and 16TCNT2 operates as an up/down-counter.

9.4.2 Basic Functions

Counter Operation: When one of bits STR0 to STR2 is set to 1 in the timer start register (TSTR), the timer counter (16TCNT) in the corresponding channel starts counting. The counting can be free-running or periodic.

- Sample setup procedure for counter
  Figure 9.12 shows a sample procedure for setting up a counter.

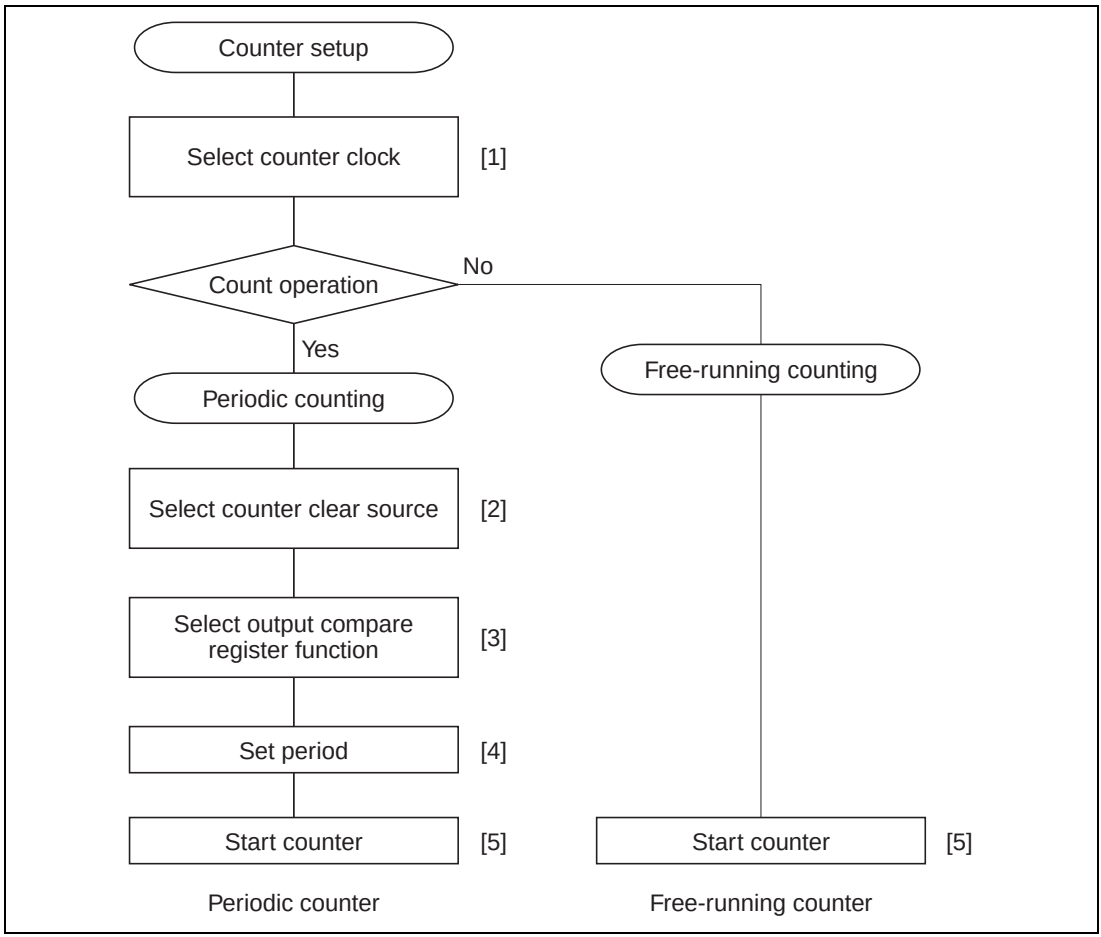


Figure 9.12 Counter Setup Procedure (Example)

1. Set bits TPSC2 to TPSC0 in 16TCR to select the counter clock source. If an external clock source is selected, set bits CKEG1 and CKEG0 in 16TCR to select the desired edge(s) of the external clock signal.
2. For periodic counting, set CCLR1 and CCLR0 in 16TCR to have 16TCNT cleared at GRA compare match or GRB compare match.
3. Set TIOR to select the output compare function of GRA or GRB, whichever was selected in step 2.
4. Write the count period in GRA or GRB, whichever was selected in step 2.
5. Set the STR bit to 1 in TSTR to start the timer counter.

- Free-running and periodic counter operation

  A reset leaves the counters (16TCNTs) in 16-bit timer channels 0 to 2 all set as free-running counters. A free-running counter starts counting up when the corresponding bit in TSTR is set to 1. When the count overflows from H'FFFF to H'0000, the OVF flag is set to 1 in TISRC. After the overflow, the counter continues counting up from H'0000. Figure 9.13 illustrates free-running counting.

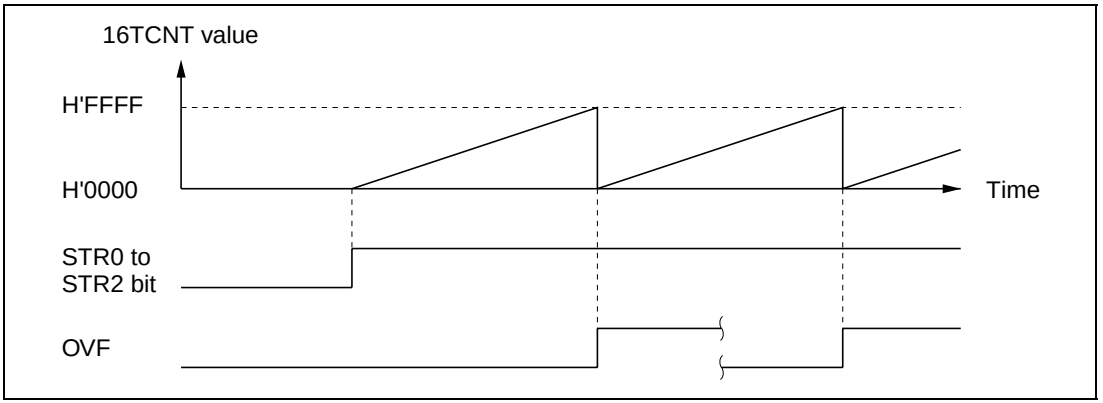


Figure 9.13 Free-Running Counter Operation

When a channel is set to have its counter cleared by compare match, in that channel 16TCNT operates as a periodic counter. Select the output compare function of GRA or GRB, set bit CCLR1 or CCLR0 in 16TCR to have the counter cleared by compare match, and set the count period in GRA or GRB. After these settings, the counter starts counting up as a periodic counter when the corresponding bit is set to 1 in TSTR. When the count matches GRA or GRB, the IMFA or IMFB flag is set to 1 in TISRA/TISRB and the counter is cleared to H'0000. If the corresponding IMIEA or IMIEB bit is set to 1 in TISRA/TISRB, a CPU interrupt is requested at this time. After the compare match, 16TCNT continues counting up from H'0000. Figure 9.14 illustrates periodic counting.

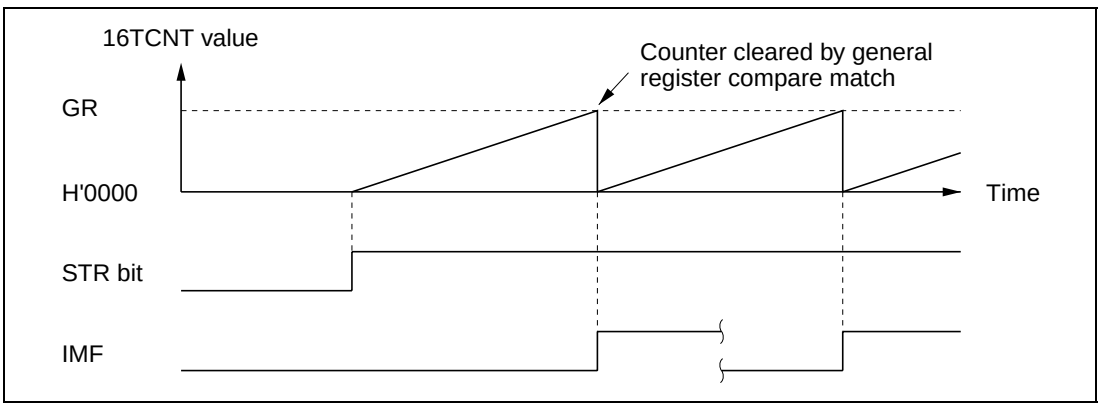


Figure 9.14 Periodic Counter Operation

- 16TCNT count timing
  - — Internal clock source

    Bits TPSC2 to TPSC0 in 16TCR select the system clock (ϕ) or one of three internal clock sources obtained by prescaling the system clock (ϕ/2, ϕ/4, ϕ/8).
    Figure 9.15 shows the timing.

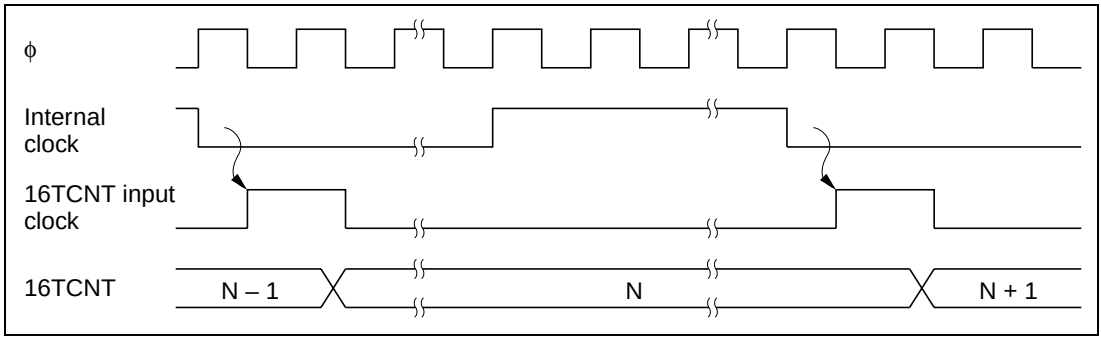


Figure 9.15 Count Timing for Internal Clock Sources

  - — External clock source

    The external clock pin (TCLKA to TCLKD) can be selected by bits TPSC2 to TPSC0 in 16TCR, and the detected edge by bits CKEG1 and CKEG0. The rising edge, falling edge, or both edges can be selected.

    The pulse width of the external clock signal must be at least 1.5 system clocks when a single edge is selected, and at least 2.5 system clocks when both edges are selected. Shorter pulses will not be counted correctly.

    Figure 9.16 shows the timing when both edges are detected.

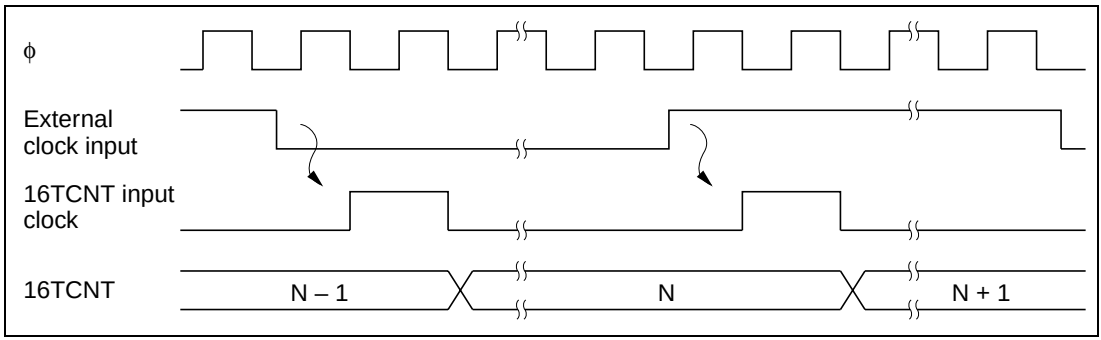


Figure 9.16 Count Timing for External Clock Sources (when Both Edges are Detected)

Waveform Output by Compare Match: In 16-bit timer channels 0, 1 compare match A or B can cause the output at the TIOCA or TIOCB pin to go to 0, go to 1, or toggle. In channel 2 the output can only go to 0 or go to 1.

- Sample setup procedure for waveform output by compare match

  Figure 9.17 shows an example of the setup procedure for waveform output by compare match.

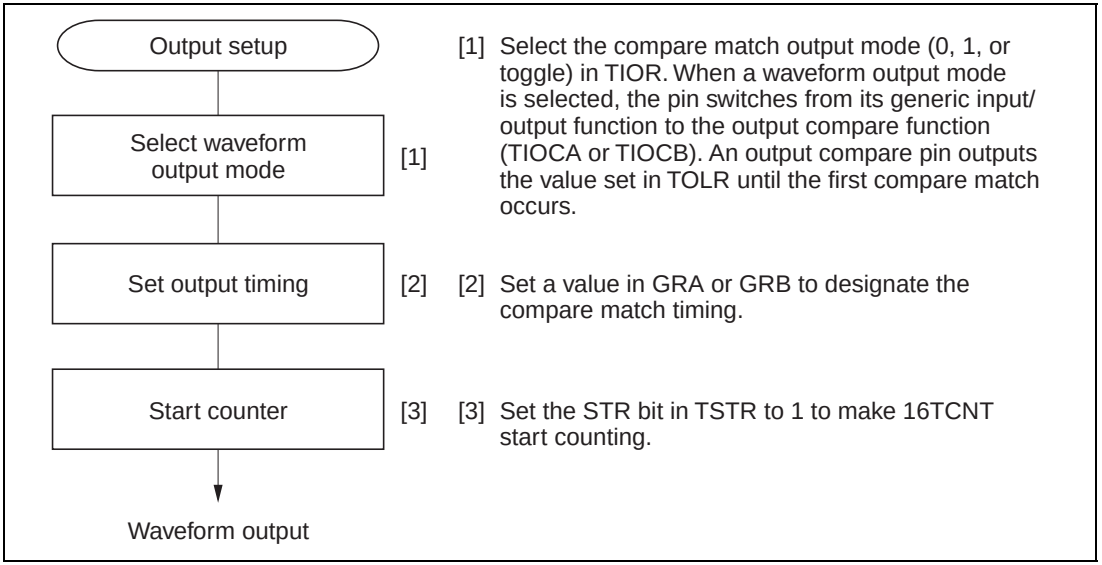


Figure 9.17 Setup Procedure for Waveform Output by Compare Match (Example)

- Examples of waveform output

  Figure 9.18 shows examples of 0 and 1 output. 16TCNT operates as a free-running counter, 0 output is selected for compare match A, and 1 output is selected for compare match B. When the pin is already at the selected output level, the pin level does not change.

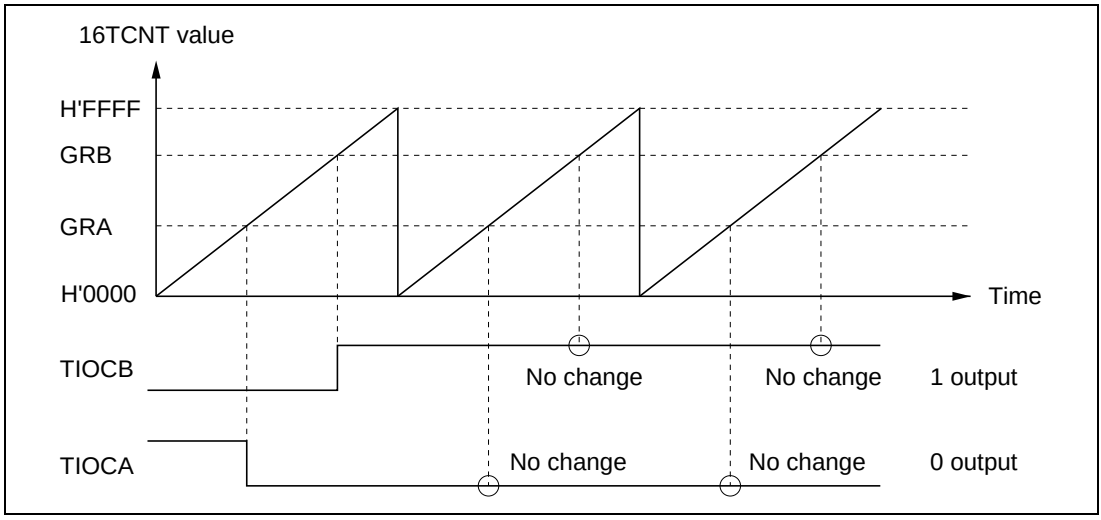


Figure 9.18 0 and 1 Output (TOA = 1, TOB = 0)

Figure 9.19 shows examples of toggle output. 16TCNT operates as a periodic counter, cleared by compare match B. Toggle output is selected for both compare match A and B.

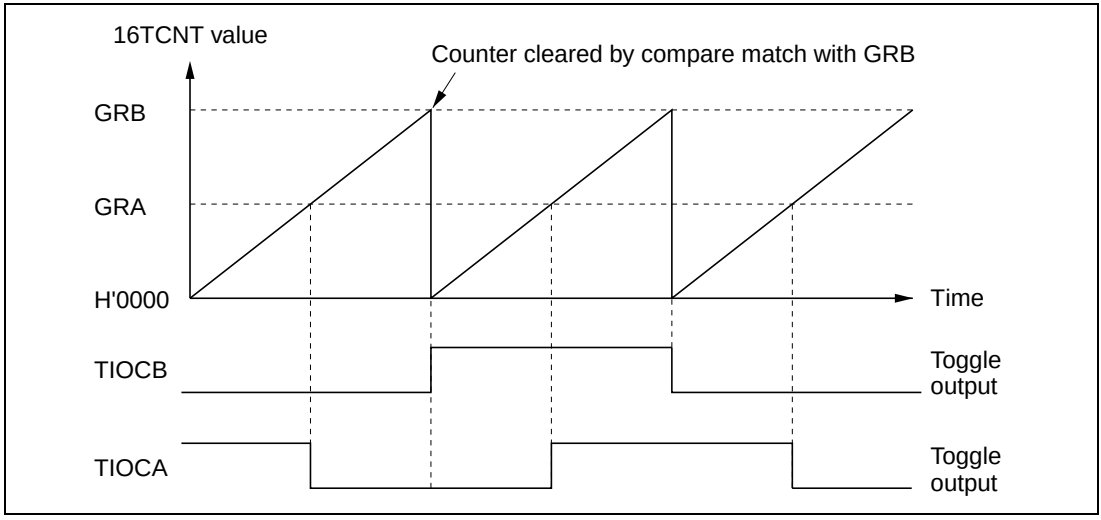


Figure 9.19 Toggle Output (TOA = 1, TOB = 0)

- Output compare output timing

  The compare match signal is generated in the last state in which 16TCNT and the general register match (when 16TCNT changes from the matching value to the next value). When the compare match signal is generated, the output value selected in TIOR is output at the output compare pin (TIOCA or TIOCB). When 16TCNT matches a general register, the compare match signal is not generated until the next counter clock pulse.

  Figure 9.20 shows the output compare timing.

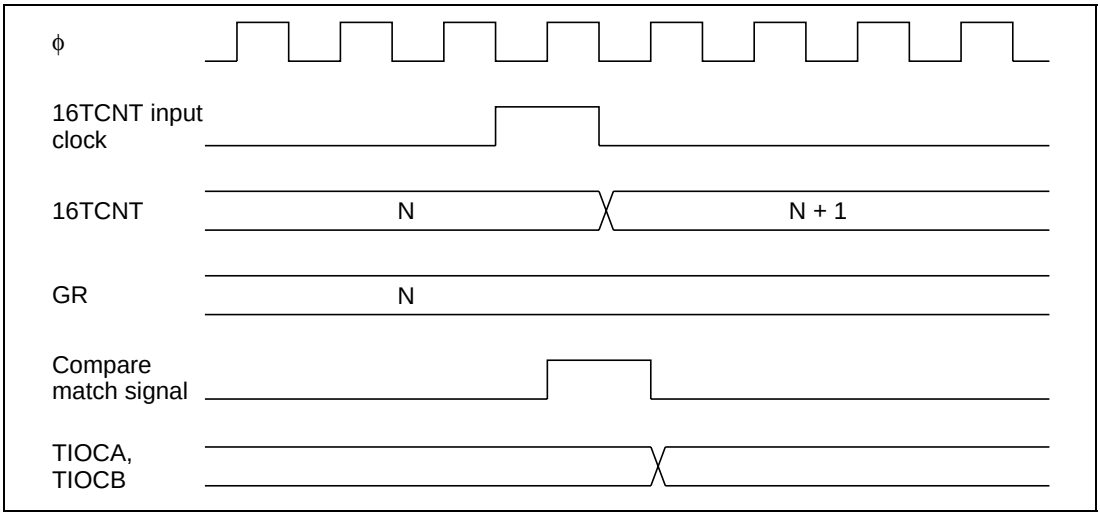


Figure 9.20 Output Compare Output Timing

Input Capture Function: The 16TCNT value can be transferred to a general register when an input edge is detected at an input capture input/output compare pin (TIOCA or TIOCB). Rising-edge, falling-edge, or both-edge detection can be selected. The input capture function can be used to measure pulse width or period.

- Sample setup procedure for input capture

  Figure 9.21 shows a sample procedure for setting up input capture.

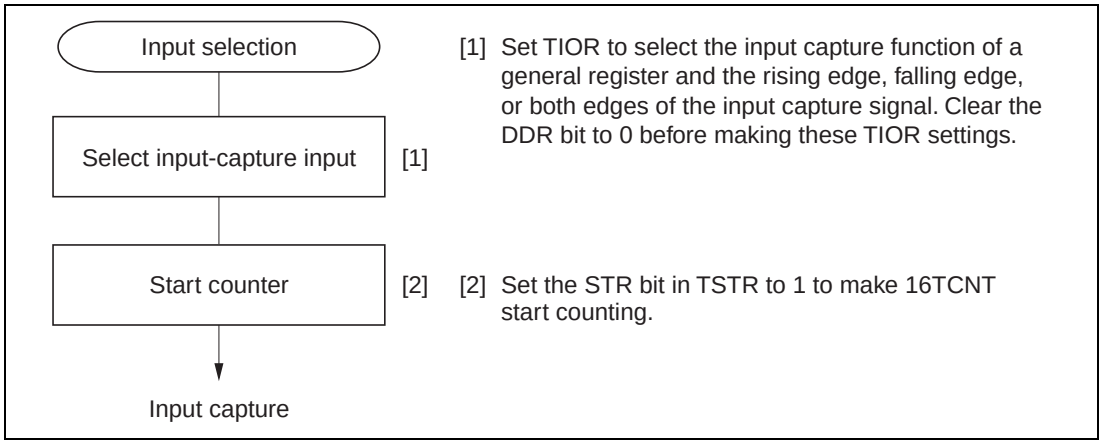


Figure 9.21 Setup Procedure for Input Capture (Example)

- Examples of input capture

  Figure 9.22 illustrates input capture when the falling edge of TIOCB and both edges of TIOCA are selected as capture edges. 16TCNT is cleared by input capture into GRB.

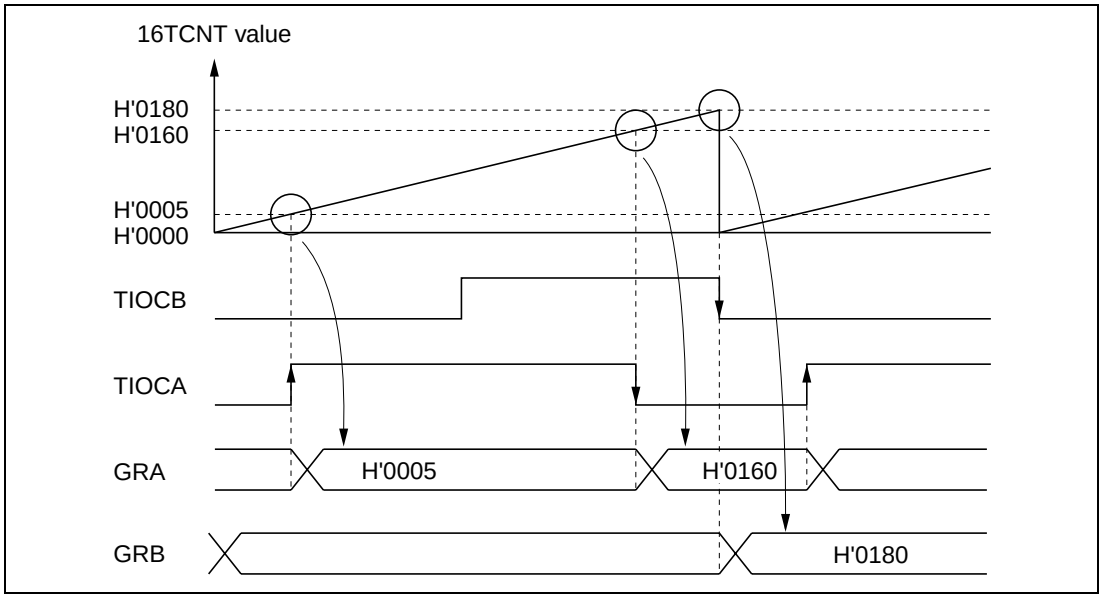


Figure 9.22 Input Capture (Example)

- Input capture signal timing

  Input capture on the rising edge, falling edge, or both edges can be selected by settings in TIOR. Figure 9.23 shows the timing when the rising edge is selected. The pulse width of the input capture signal must be at least 1.5 system clocks for single-edge capture, and 2.5 system clocks for capture of both edges.

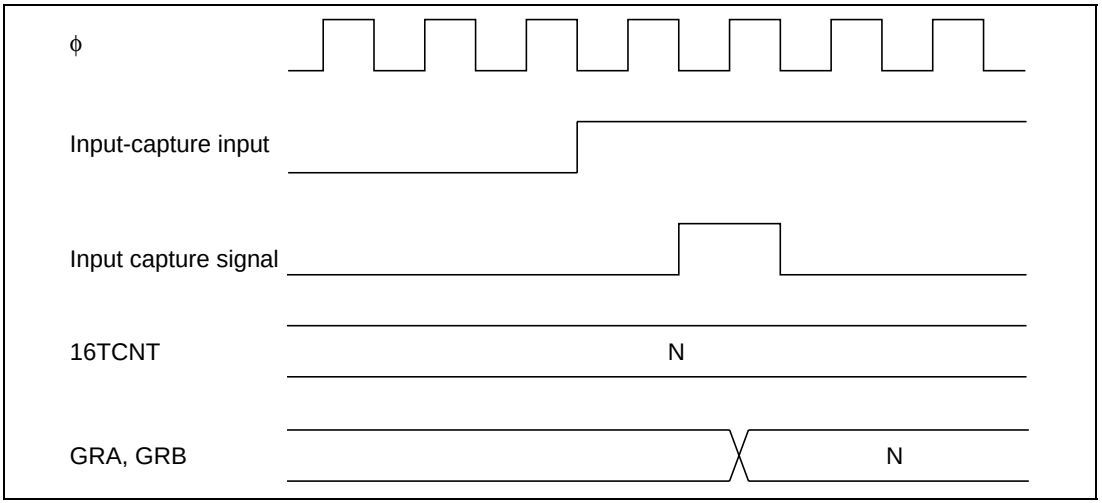
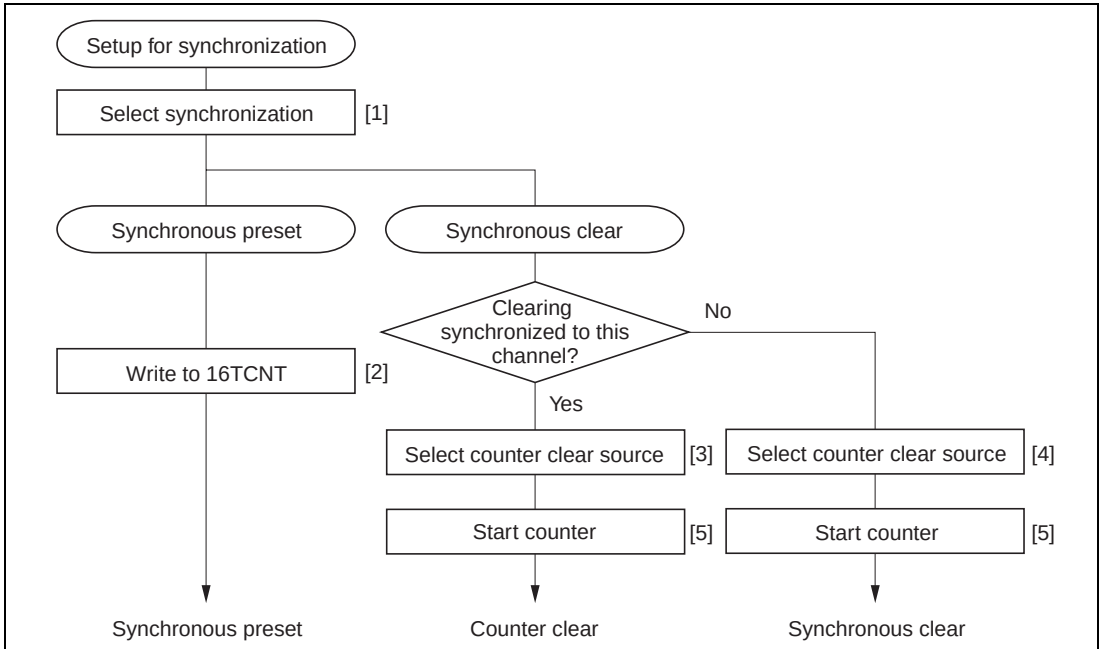


Figure 9.23 Input Capture Signal Timing

9.4.3 Synchronization

The synchronization function enables two or more timer counters to be synchronized by writing the same data to them simultaneously (synchronous preset). With appropriate 16TCR settings, two or more timer counters can also be cleared simultaneously (synchronous clear). Synchronization enables additional general registers to be associated with a single time base. Synchronization can be selected for all channels (0 to 2).

Sample Setup Procedure for Synchronization: Figure 9.24 shows a sample procedure for setting up synchronization.



[1] Set the SYNC bits to 1 in TSNC for the channels to be synchronized.

[2] When a value is written in 16TCNT in one of the synchronized channels, the same value is simultaneously written in 16TCNT in the other channels.

[3] Set the CCLR1 or CCLR0 bit in 16TCR to have the counter cleared by compare match or input capture.

[4] Set the CCLR1 and CCLR0 bits in 16TCR to have the counter cleared synchronously.

[5] Set the STR bits in TSTR to 1 to start the synchronized counters.

Figure 9.24 Setup Procedure for Synchronization (Example)

Example of Synchronization: Figure 9.25 shows an example of synchronization. Channels 0, 1, and 2 are synchronized, and are set to operate in PWM mode. Channel 0 is set for counter clearing by compare match with GRB0. Channels 1 and 2 are set for synchronous counter clearing. The timer counters in channels 0, 1, and 2 are synchronously preset, and are synchronously cleared by compare match with GRB0. A three-phase PWM waveform is output from pins $TIOCA_0$, $TIOCA_1$, and $TIOCA_2$. For further information on PWM mode, see section 9.4.4, PWM Mode.

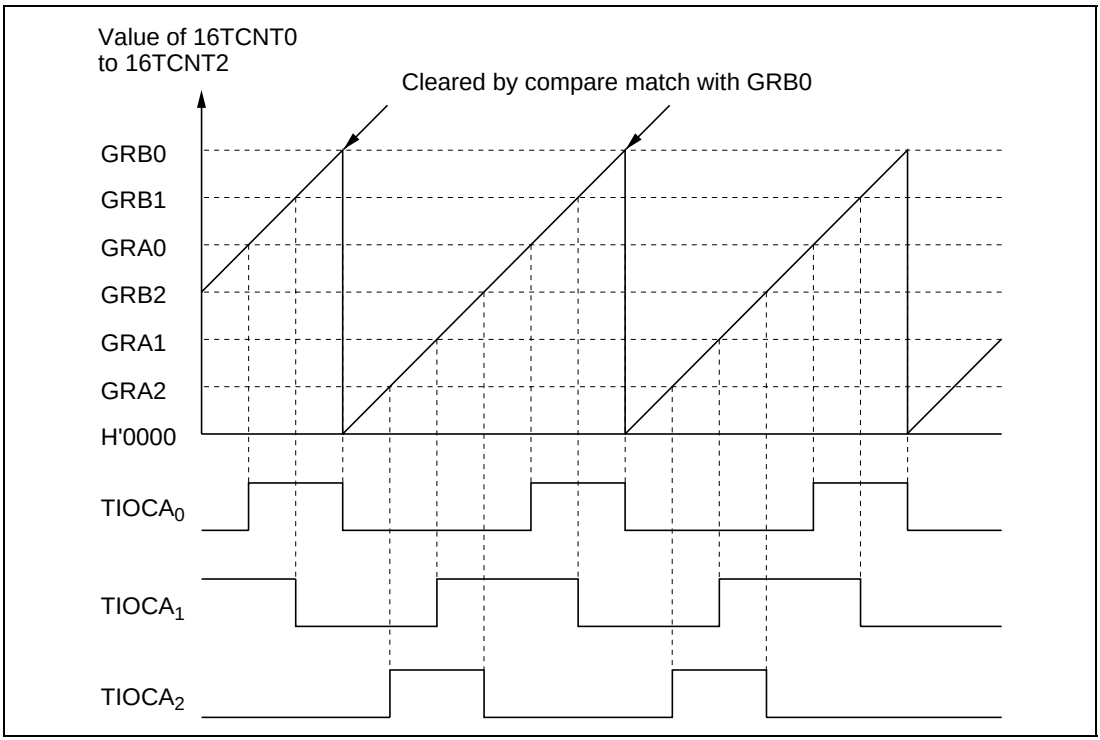


Figure 9.25 Synchronization (Example)

9.4.4 PWM Mode

In PWM mode GRA and GRB are paired and a PWM waveform is output from the TIOCA pin. GRA specifies the time at which the PWM output changes to 1. GRB specifies the time at which the PWM output changes to 0. If either GRA or GRB compare match is selected as the counter clear source, a PWM waveform with a duty cycle from 0% to 100% is output at the TIOCA pin. PWM mode can be selected in all channels (0 to 2).

Table 9.4 summarizes the PWM output pins and corresponding registers. If the same value is set in GRA and GRB, the output does not change when compare match occurs.

Table 9.4 PWM Output Pins and Registers

Channel	Output Pin	1 Output	0 Output
0	$TIOCA_0$	GRA0	GRB0
1	$TIOCA_1$	GRA1	GRB1
2	$TIOCA_2$	GRA2	GRB2

Sample Setup Procedure for PWM Mode: Figure 9.26 shows a sample procedure for setting up PWM mode.

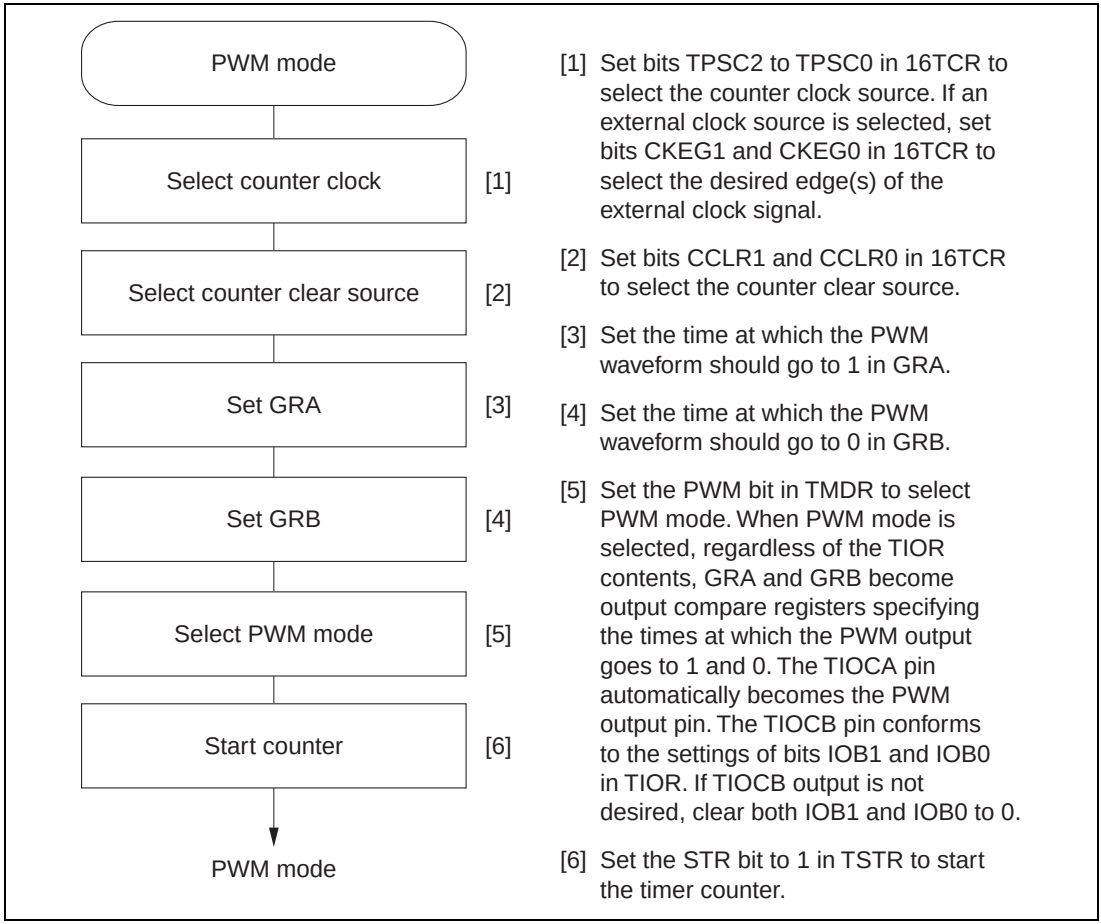


Figure 9.26 Setup Procedure for PWM Mode (Example)

Examples of PWM Mode: Figure 9.27 shows examples of operation in PWM mode. In PWM mode TIOCA becomes an output pin. The output goes to 1 at compare match with GRA, and to 0 at compare match with GRB.

In the examples shown, 16TCNT is cleared by compare match with GRA or GRB. Synchronized operation and free-running counting are also possible.

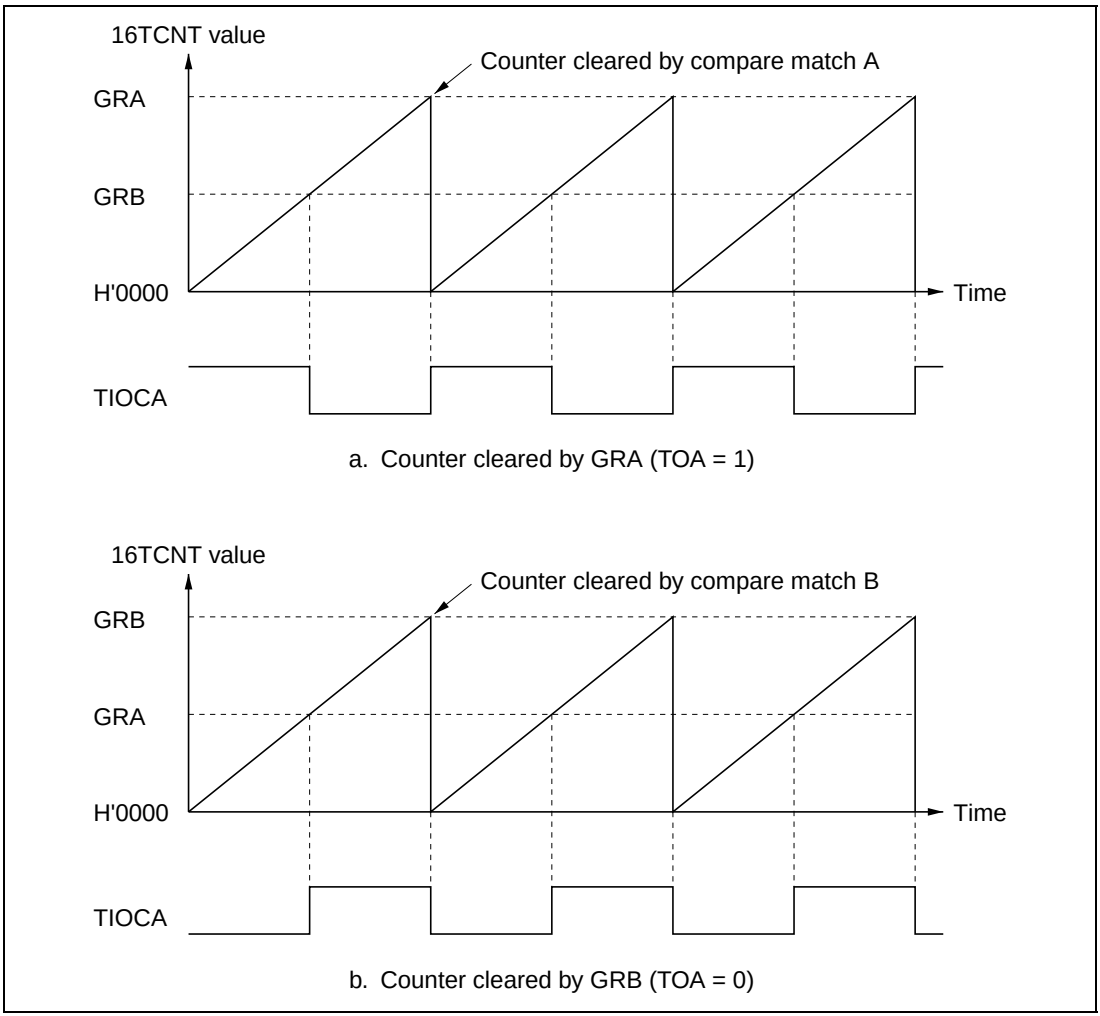


Figure 9.27 PWM Mode (Example 1)

Figure 9.28 shows examples of the output of PWM waveforms with duty cycles of 0% and 100%. If the counter is cleared by compare match with GRB, and GRA is set to a higher value than GRB, the duty cycle is 0%. If the counter is cleared by compare match with GRA, and GRB is set to a higher value than GRA, the duty cycle is 100%.

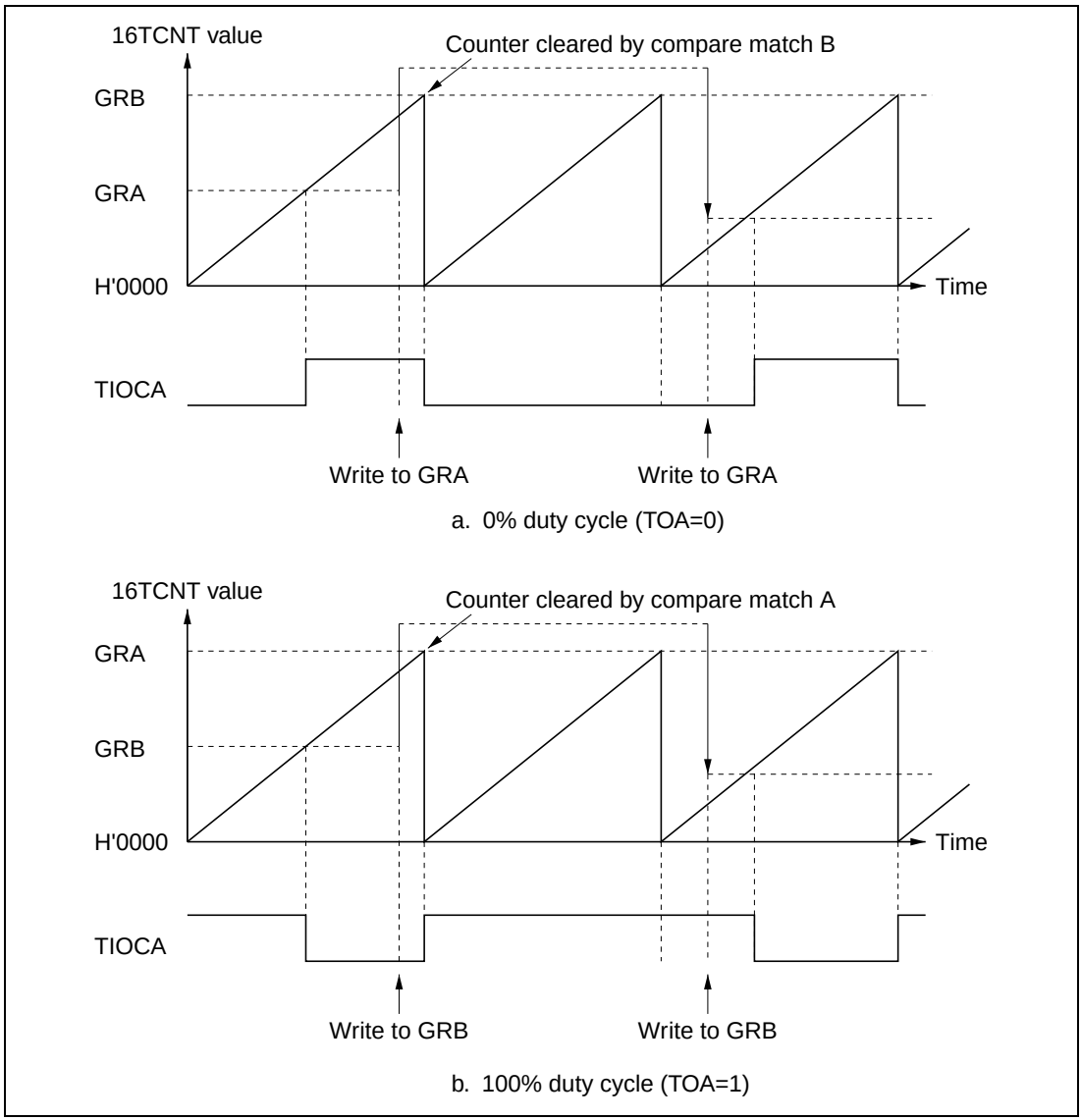


Figure 9.28 PWM Mode (Example 2)

9.4.5 Phase Counting Mode

In phase counting mode the phase difference between two external clock inputs (at the TCLKA and TCLKB pins) is detected, and 16TCNT2 counts up or down accordingly.

In phase counting mode, the TCLKA and TCLKB pins automatically function as external clock input pins and 16TCNT2 becomes an up/down-counter, regardless of the settings of bits TPSC2 to TPSC0, CKEG1, and CKEG0 in 16TCR2. Settings of bits CCLR1, CCLR0 in 16TCR2, and settings in TIOR2, TISRA, TISRB, TISRC, setting of STR2 bit in TSTR, GRA2, and GRB2 are valid. The input capture and output compare functions can be used, and interrupts can be generated.

Phase counting is available only in channel 2.

Sample Setup Procedure for Phase Counting Mode: Figure 9.29 shows a sample procedure for setting up phase counting mode.

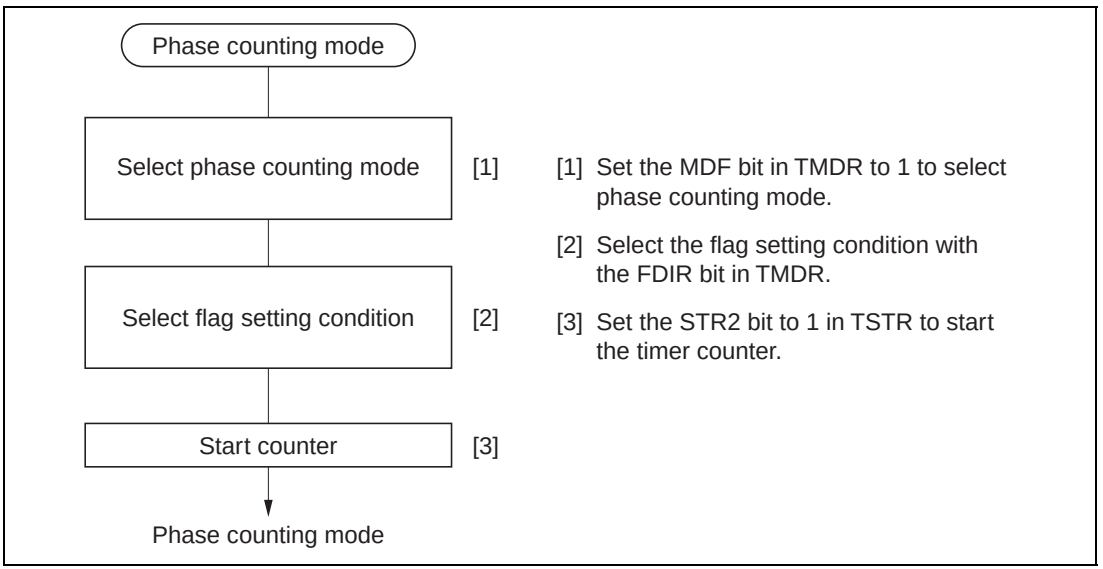


Figure 9.29 Setup Procedure for Phase Counting Mode (Example)

Example of Phase Counting Mode: Figure 9.30 shows an example of operations in phase counting mode. Table 9.5 lists the up-counting and down-counting conditions for 16TCNT2.

In phase counting mode both the rising and falling edges of TCLKA and TCLKB are counted. The phase difference between TCLKA and TCLKB must be at least 1.5 states, the phase overlap must also be at least 1.5 states, and the pulse width must be at least 2.5 states.

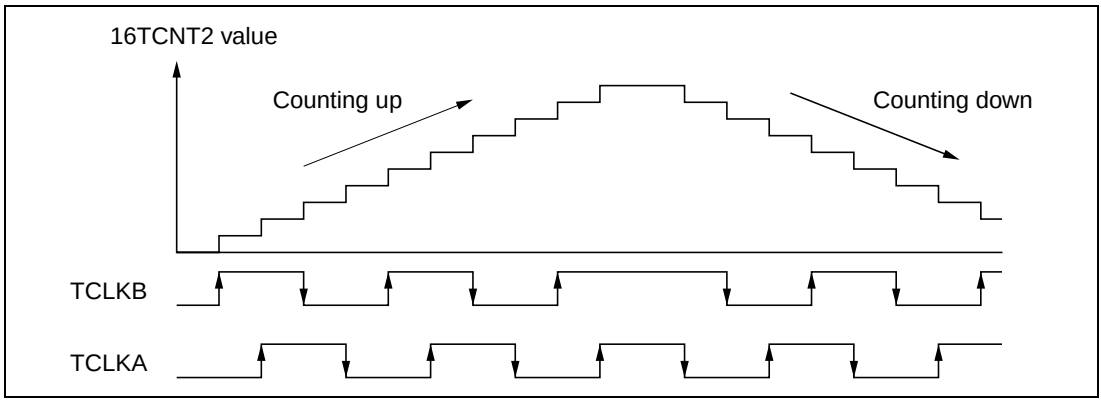


Figure 9.30 Operation in Phase Counting Mode (Example)

Table 9.5 Up/Down Counting Conditions

Counting Direction	Up-Counting				Down-Counting			
TCLKB pin	↑	High	↓	Low	HIgh	↓	Low	↑
TCLKA pin	Low	↑	High	↓	↓	Low	↑	HIgh

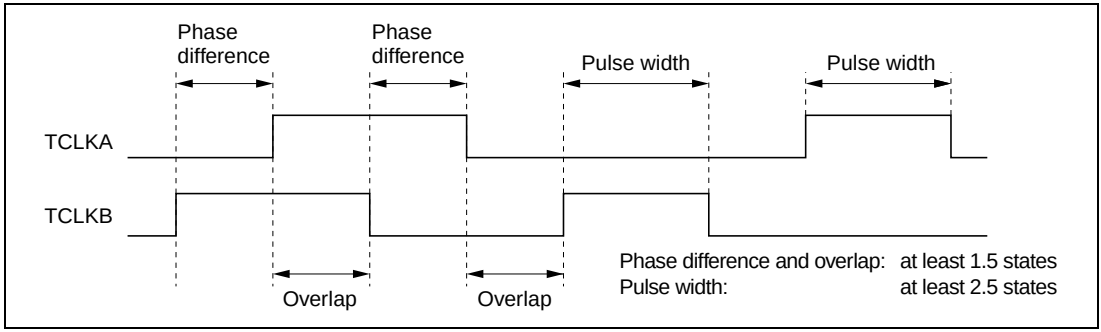


Figure 9.31 Phase Difference, Overlap, and Pulse Width in Phase Counting Mode

9.4.6 16-Bit Timer Output Timing

The initial value of 16-bit timer output when a timer count operation begins can be specified arbitrarily by making a setting in TOLR.

Figure 9.32 shows the timing for setting the initial value with TOLR.

Only write to TOLR when the corresponding bit in TSTR is cleared to 0.

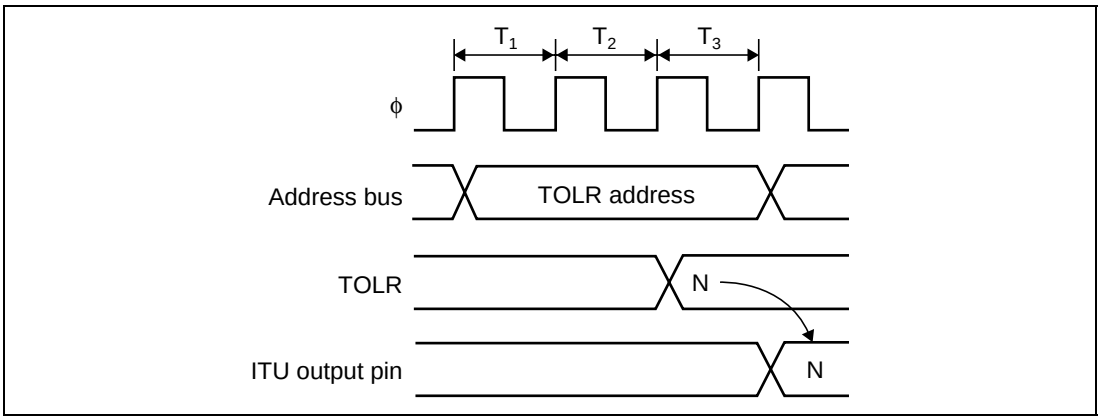


Figure 9.32 Timing for Setting 16-Bit Timer Output Level by Writing to TOLR

9.5 Interrupts

The 16-bit timer has two types of interrupts: input capture/compare match interrupts, and overflow interrupts.

9.5.1 Setting of Status Flags

Timing of Setting of IMFA and IMFB at Compare Match: IMFA and IMFB are set to 1 by a compare match signal generated when 16TCNT matches a general register (GR). The compare match signal is generated in the last state in which the values match (when 16TCNT is updated from the matching count to the next count). Therefore, when 16TCNT matches a general register, the compare match signal is not generated until the next 16TCNT clock input. Figure 9.33 shows the timing of the setting of IMFA and IMFB.

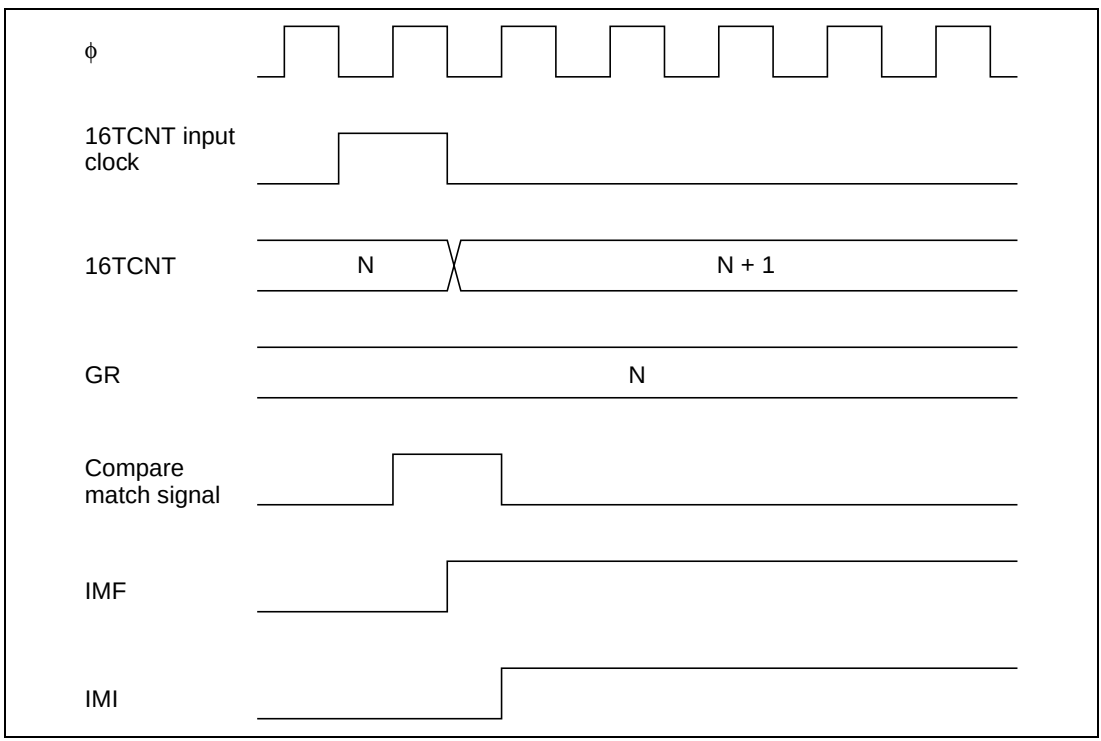


Figure 9.33 Timing of Setting of IMFA and IMFB by Compare Match

Timing of Setting of IMFA and IMFB by Input Capture: IMFA and IMFB are set to 1 by an input capture signal. The 16TCNT contents are simultaneously transferred to the corresponding general register. Figure 9.34 shows the timing.

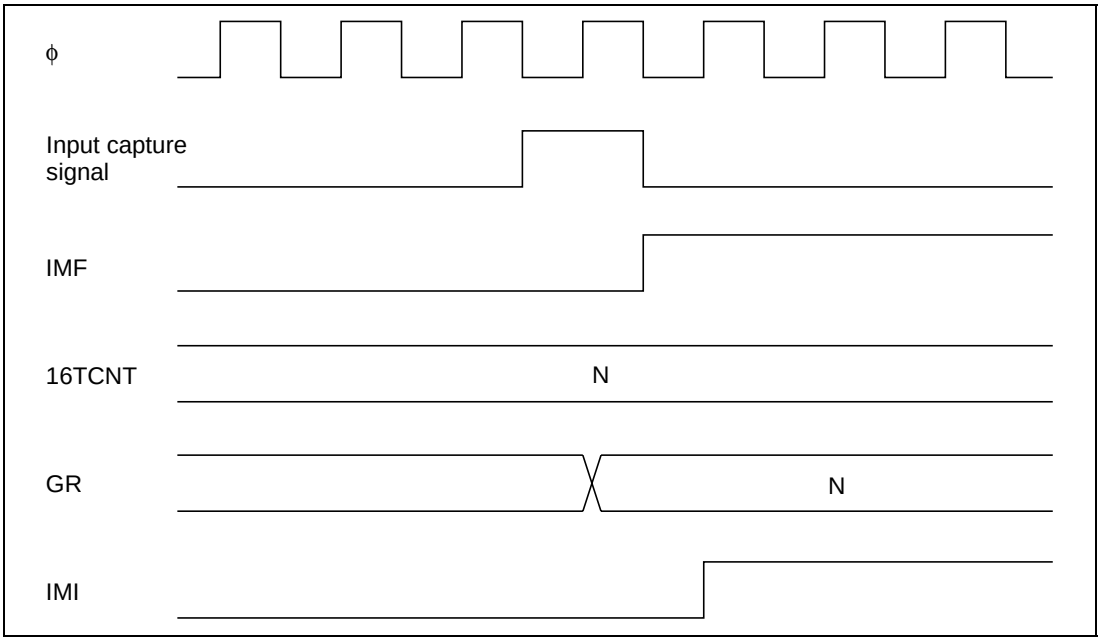


Figure 9.34 Timing of Setting of IMFA and IMFB by Input Capture

Timing of Setting of Overflow Flag (OVF): OVF is set to 1 when 16TCNT overflows from H'FFFF to H'0000 or underflows from H'0000 to H'FFFF. Figure 9.35 shows the timing.

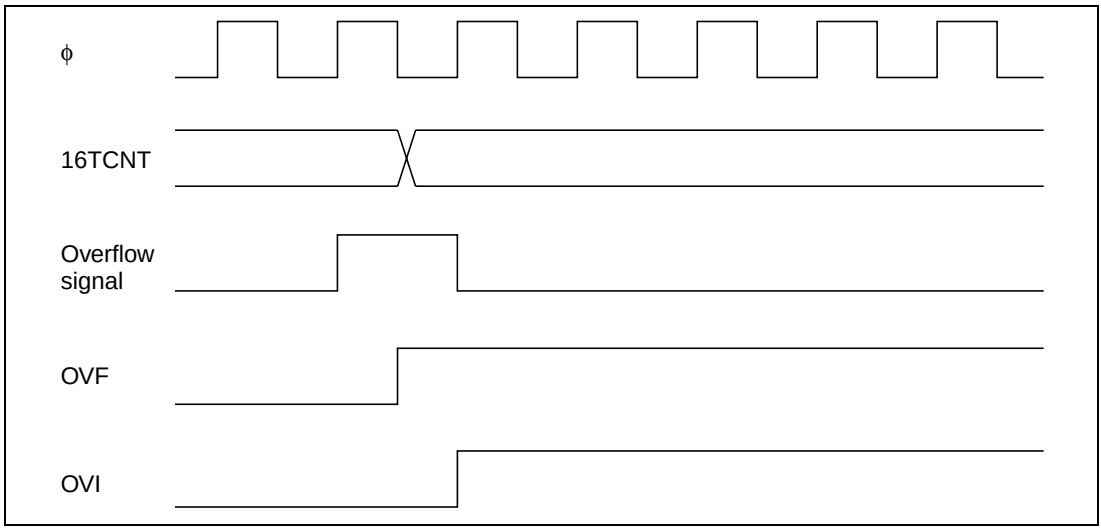


Figure 9.35 Timing of Setting of OVF

9.5.2 Timing of Clearing of Status Flags

If the CPU reads a status flag while it is set to 1, then writes 0 in the status flag, the status flag is cleared. Figure 9.36 shows the timing.

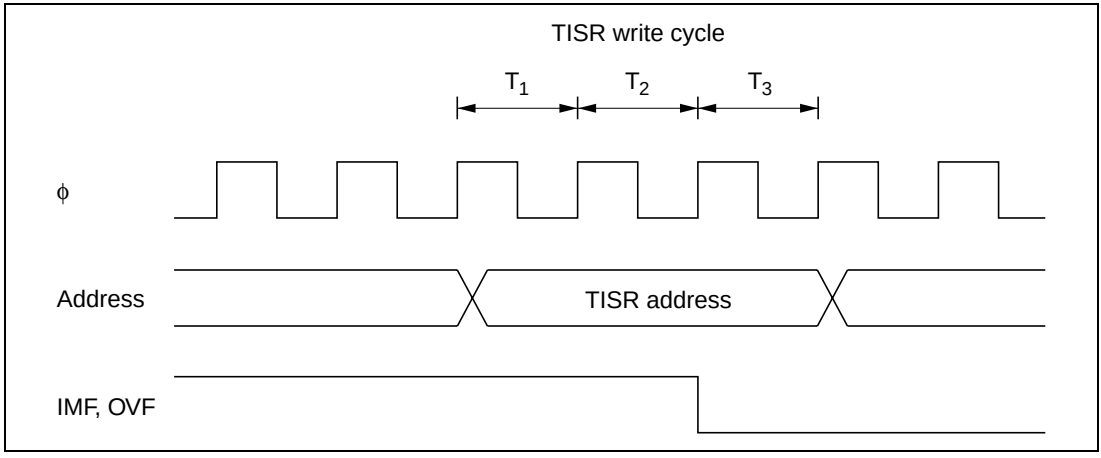


Figure 9.36 Timing of Clearing of Status Flags

9.5.3 Interrupt Sources

Each 16-bit timer channel can generate a compare match/input capture A interrupt, a compare match/input capture B interrupt, and an overflow interrupt. In total there are nine interrupt sources of three kinds, all independently vectored. An interrupt is requested when the interrupt request flag are set to 1.

The priority order of the channels can be modified in interrupt priority registers A (IPRA). For details see section 5, Interrupt Controller.

Table 9.6 lists the interrupt sources.

Table 9.6 16-bit timer Interrupt Sources

Channel	Interrupt Source	Description	Priority*
0	IMIA0	Compare match/input capture A0	High
	IMIB0	Compare match/input capture B0	
	OVI0	Overflow 0	
1	IMIA1	Compare match/input capture A1	
	IMIB1	Compare match/input capture B1	
	OVI1	Overflow 1	
2	IMIA2	Compare match/input capture A2	
	IMIB2	Compare match/input capture B2	
	OVI2	Overflow 2	Low

Note: * The priority immediately after a reset is indicated. Inter-channel priorities can be changed by settings in IPRA.

9.6 Usage Notes

This section describes contention and other matters requiring special attention during 16-bit timer operations.

Contention between 16TCNT Write and Clear: If a counter clear signal occurs in the T_3 state of a 16TCNT write cycle, clearing of the counter takes priority and the write is not performed. See figure 9.37.

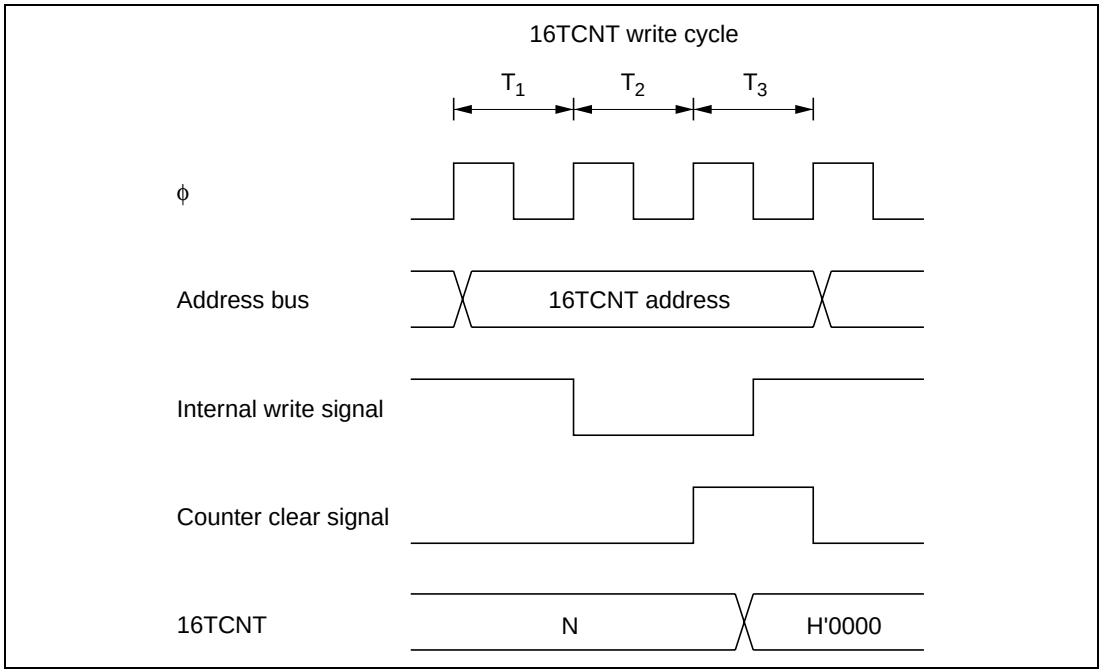


Figure 9.37 Contention between 16TCNT Write and Clear

Contention between 16TCNT Word Write and Increment: If an increment pulse occurs in the T_3 state of a 16TCNT word write cycle, writing takes priority and 16TCNT is not incremented. Figure 9.38 shows the timing in this case.

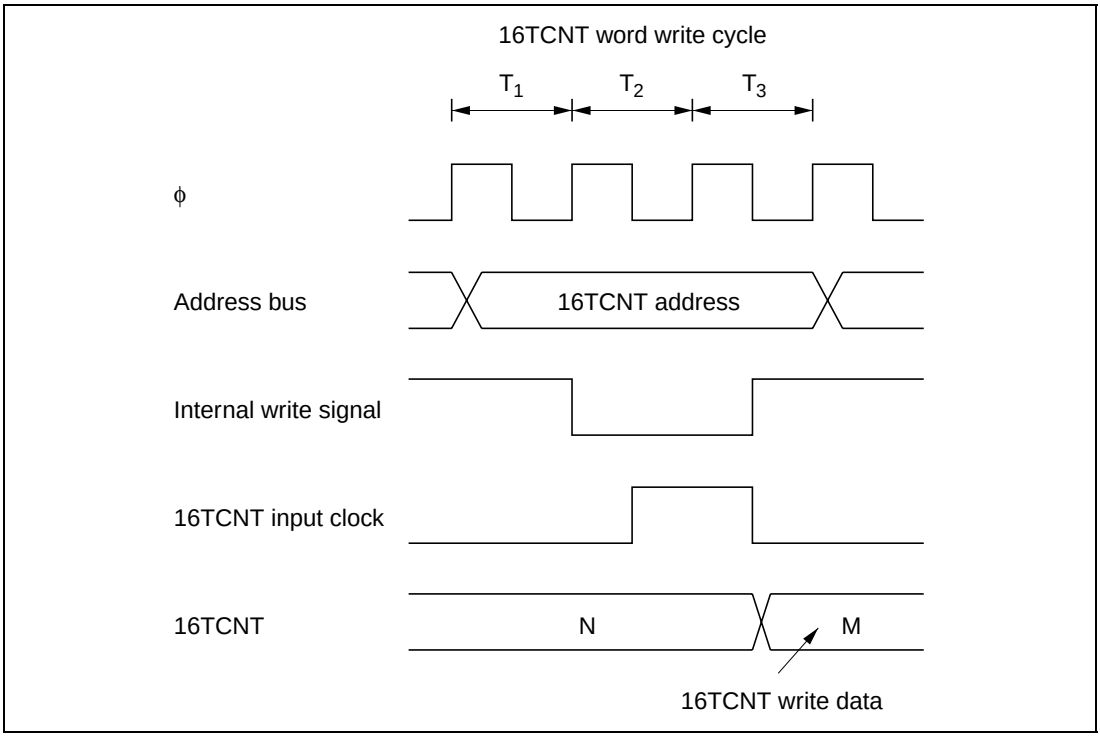


Figure 9.38 Contention between 16TCNT Word Write and Increment

Contention between 16TCNT Byte Write and Increment: If an increment pulse occurs in the T_2 or T_3 state of a 16TCNT byte write cycle, writing takes priority and 16TCNT is not incremented. The byte data for which a write was not performed is not incremented, and retains its pre-write value. See figure 9.39, which shows an increment pulse occurring in the T_2 state of a byte write to 16TCNTH.

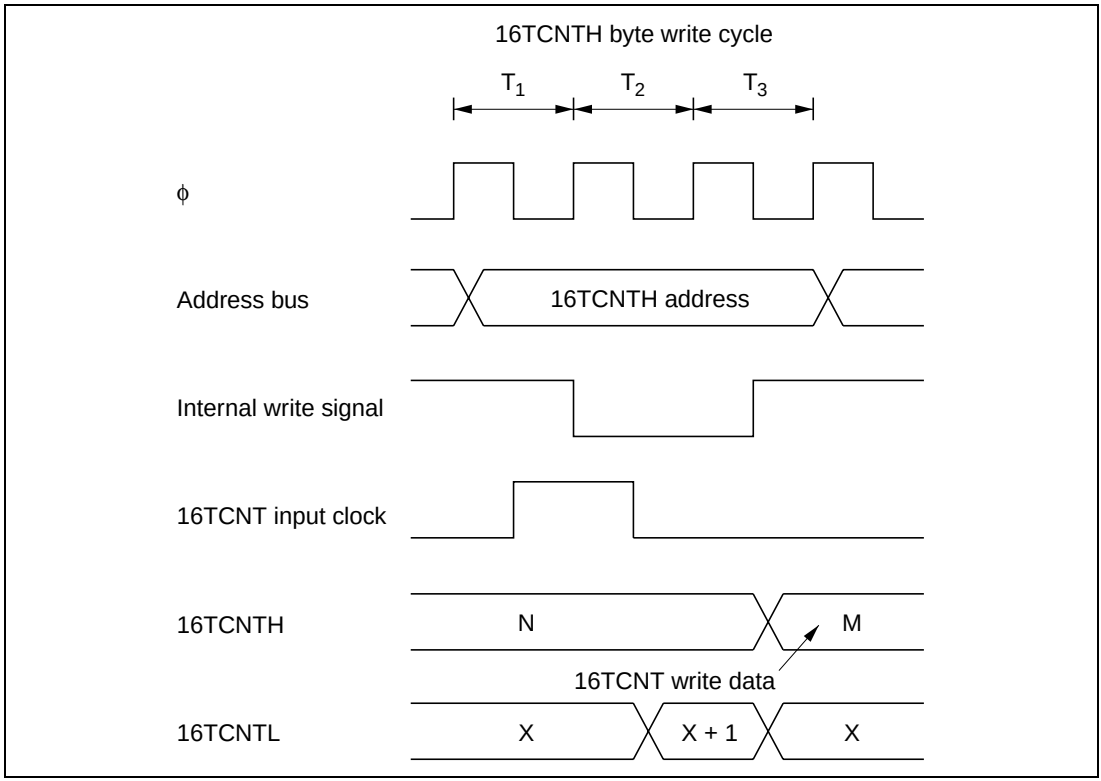


Figure 9.39 Contention between 16TCNT Byte Write and Increment

Contention between General Register Write and Compare Match: If a compare match occurs in the T_3 state of a general register write cycle, writing takes priority and the compare match signal is inhibited. See figure 9.40.

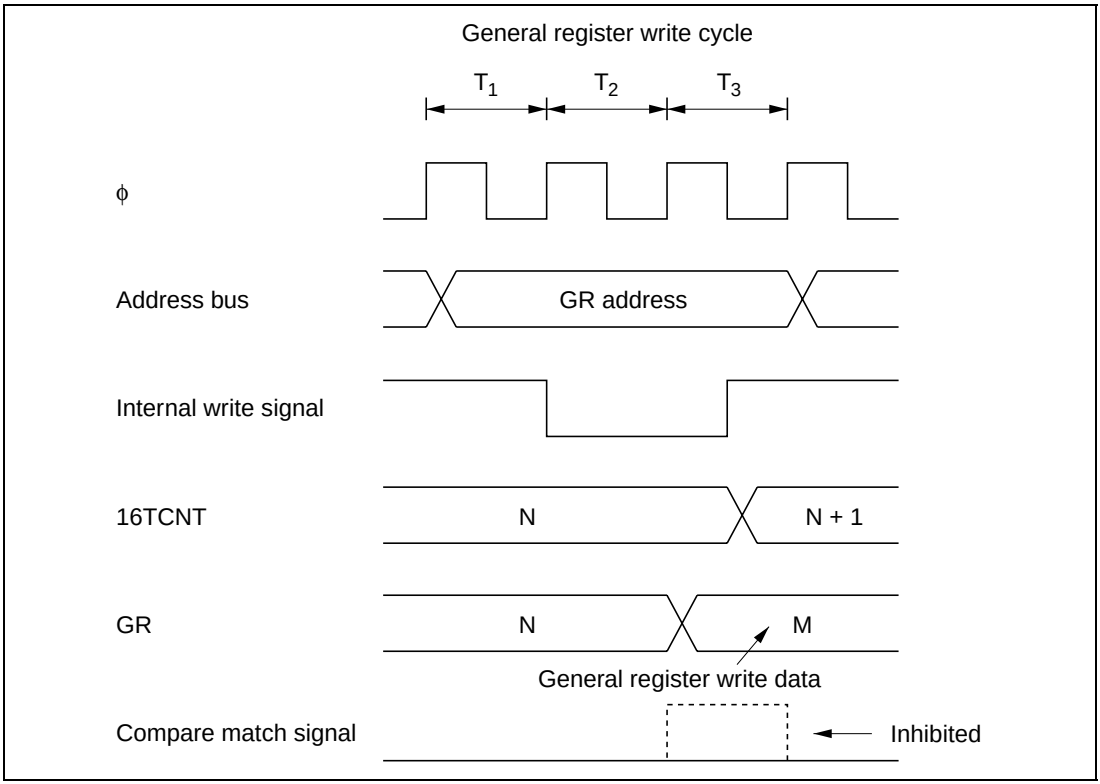


Figure 9.40 Contention between General Register Write and Compare Match

Contention between 16TCNT Write and Overflow or Underflow: If an overflow occurs in the T_3 state of a 16TCNT write cycle, writing takes priority and the counter is not incremented. OVF is set to 1. The same holds for underflow. See figure 9.41.

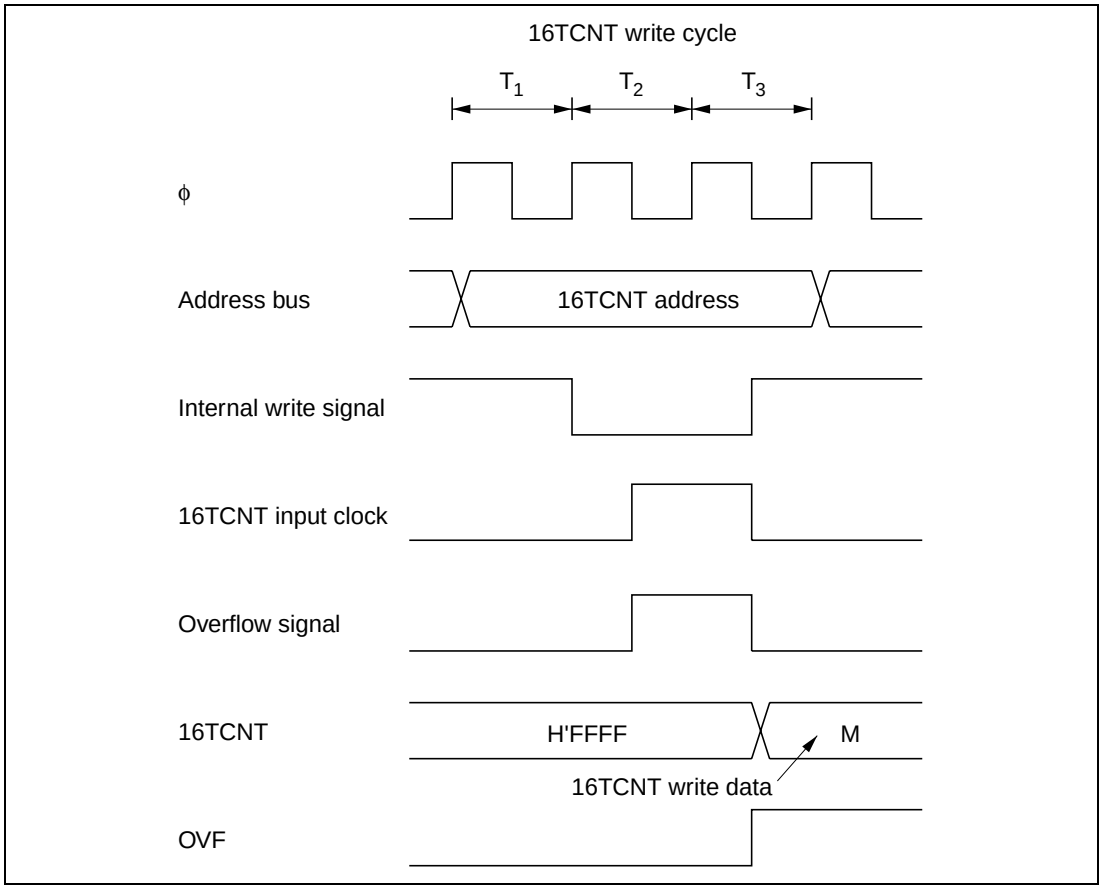


Figure 9.41 Contention between 16TCNT Write and Overflow

Contention between General Register Read and Input Capture: If an input capture signal occurs during the T_3 state of a general register read cycle, the value before input capture is read. See figure 9.42.

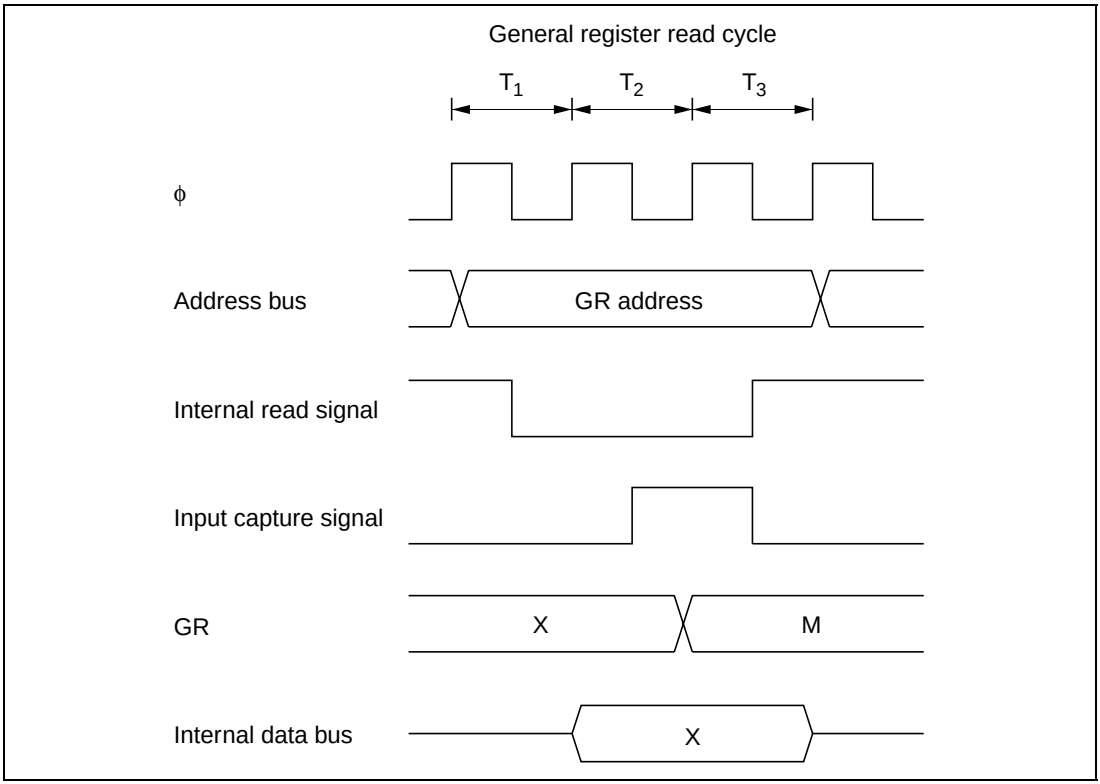


Figure 9.42 Contention between General Register Read and Input Capture

Contention between Counter Clearing by Input Capture and Counter Increment: If an input capture signal and counter increment signal occur simultaneously, the counter is cleared according to the input capture signal. The counter is not incremented by the increment signal. The value before the counter is cleared is transferred to the general register. See figure 9.43.

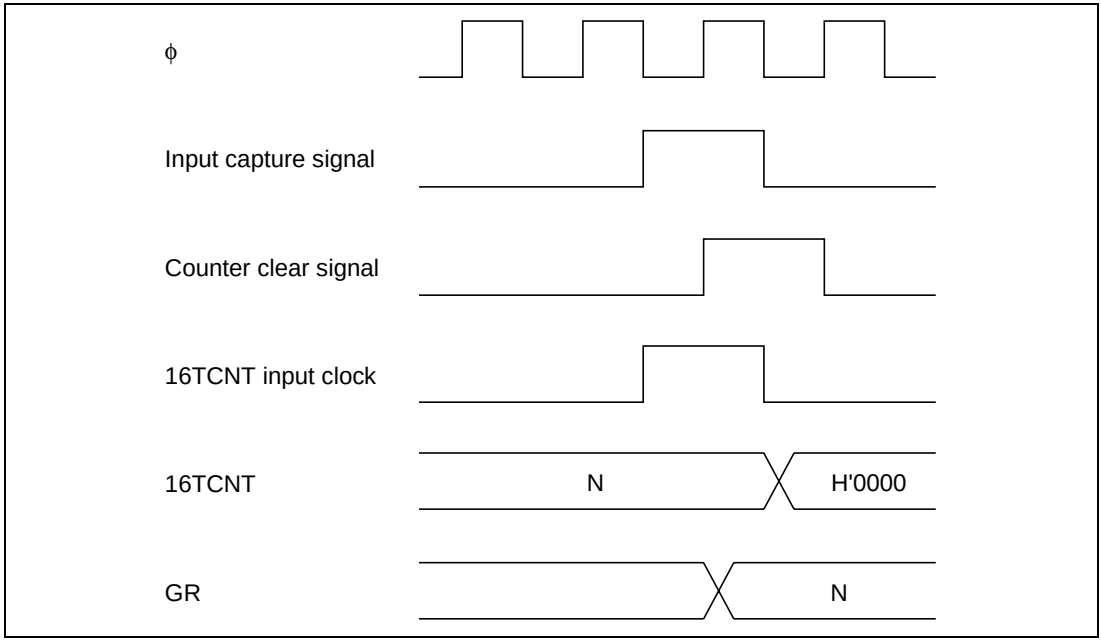


Figure 9.43 Contention between Counter Clearing by Input Capture and Counter Increment

Contention between General Register Write and Input Capture: If an input capture signal occurs in the T_3 state of a general register write cycle, input capture takes priority and the write to the general register is not performed. See figure 9.44.

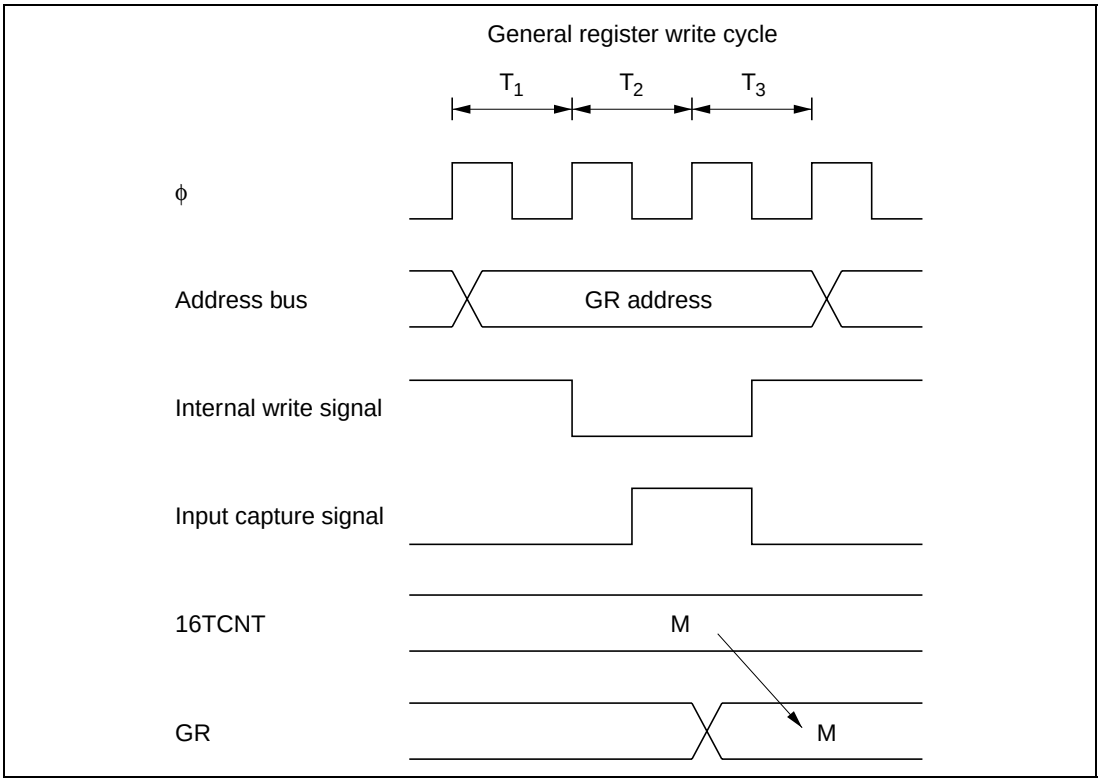


Figure 9.44 Contention between General Register Write and Input Capture

Note on Waveform Period Setting: When a counter is cleared by compare match, the counter is cleared in the last state at which the 16TCNT value matches the general register value, at the time when this value would normally be updated to the next count. The actual counter frequency is therefore given by the following formula:

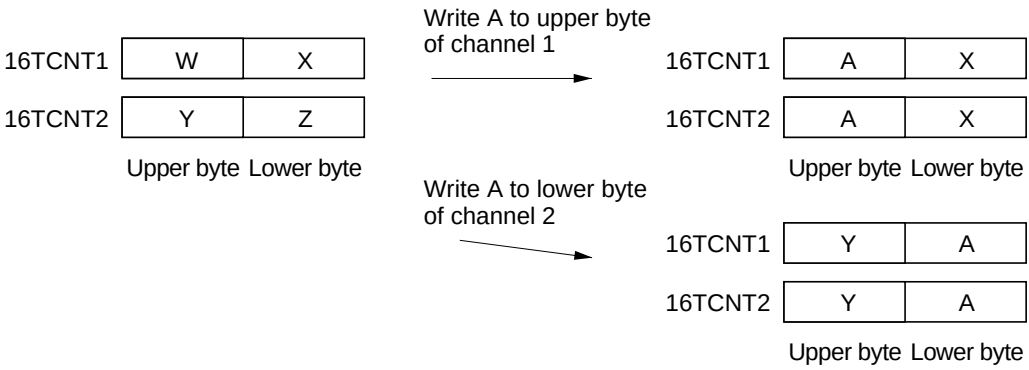
$$f = \frac{\phi}{(N+1)}$$

(f: counter frequency. ϕ: system clock frequency. N: value set in general register.)

Note on Writes in Synchronized Operation: When channels are synchronized, if a 16TCNT value is modified by byte write access, all 16 bits of all synchronized counters assume the same value as the counter that was addressed.

(Example) When channels 1 and 2 are synchronized

- Byte write to channel 1 or byte write to channel 2



- Word write to channel 1 or word write to channel 2

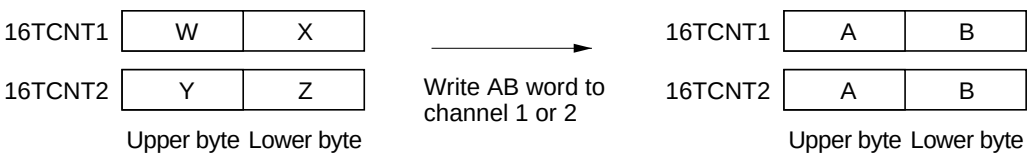


Table 9.7 (a)16-bit timer Operating Modes (Channel 0)

		Register Settings							
		TSNC	TMDR			TIOR0		16TCR0	
Operating Mode		Synchro-nization	MDF	FDIR	PWM	IOA	IOB	Clear Select	Clock Select
Synchronous preset		SYNC0 = 1	—	—	○	○	○	○	○
PWM mode		○	—	—	PWM0 = 1	—	○*	○	○
Output compare A		○	—	—	PWM0 = 0	IOA2 = 0 Other bits unrestricted	○	○	○
Output compare B		○	—	—	○	○	IOB2 = 0 Other bits unrestricted	○	○
Input capture A		○	—	—	PWM0 = 0	IOA2 = 1 Other bits unrestricted	○	○	○
Input capture B		○	—	—	PWM0 = 0	○	IOB2 = 1 Other bits unrestricted	○	○
Counter clearing	By compare match/input capture A	○	—	—	○	○	○	CCLR1 = 0 CCLR0 = 1	○
	By compare match/input capture B	○	—	—	○	○	○	CCLR1 = 1 CCLR0 = 0	○
	Syn-chronous clear	SYNC0 = 1	—	—	○	○	○	CCLR1 = 1 CCLR0 = 1	○

[Legend] ○ : Setting available (valid).
— : Setting does not affect this mode.

Note: * The input capture function cannot be used in PWM mode. If compare match A and compare match B occur simultaneously, the compare match signal is inhibited.

Table 9.7 (b) 16-bit timer Operating Modes (Channel 1)

		Register Settings						
		TSNC	TMDR			TIOR1		16TCR1	
Operating Mode		Synchro-nization	MDF	FDIR	PWM	IOA	IOB	Clear Select	Clock Select
Synchronous preset		SYNC1 = 1	—	—	○	○	○	○	○
PWM mode		○	—	—	PWM1 = 1	—	○*	○	○
Output compare A		○	—	—	PWM1 = 0	IOA2 = 0 Other bits unrestricted	○	○	○
Output compare B		○	—	—	○	○	IOB2 = 0 Other bits unrestricted	○	○
Input capture A		○	—	—	PWM1 = 0	IOA2 = 1 Other bits unrestricted	○	○	○
Input capture B		○	—	—	PWM1 = 0	○	IOB2 = 1 Other bits unrestricted	○	○
Counter clearing	By compare match/input capture A	○	—	—	○	○	○	CCLR1 = 0 CCLR0 = 1	○
	By compare match/input capture B	○	—	—	○	○	○	CCLR1 = 1 CCLR0 = 0	○
	Syn-chronous clear	SYNC1 = 1	—	—	○	○	○	CCLR1 = 1 CCLR0 = 1	○

[Legend] ○ : Setting available (valid).
— : Setting does not affect this mode.

Note: * The input capture function cannot be used in PWM mode. If compare match A and compare match B occur simultaneously, the compare match signal is inhibited.

Table 9.7 (c) 16-bit timer Operating Modes (Channel 2)

		Register Settings							
		TSNC	TMDR			TIOR2		16TCR2	
Operating Mode		Synchro-nization	MDF	FDIR	PWM	IOA	IOB	Clear Select	Clock Select
Synchronous preset		SYNC2 = 1	○	—	○	○	○	○	○
PWM mode		○	○	—	PWM2 = 1	—	○*	○	○
Output compare A		○	○	—	PWM2 = 0	IOA2 = 0 Other bits unrestricted	○	○	○
Output compare B		○	○	—	○	○	IOB2 = 0 Other bits unrestricted	○	○
Input capture A		○	○	—	PWM2 = 0	IOA2 = 1 Other bits unrestricted	○	○	○
Input capture B		○	○	—	PWM2 = 0	○	IOB2 = 1 Other bits unrestricted	○	○
Counter clearing	By compare match/input capture A	○	○	—	○	○	○	CCLR1 = 0 CCLR0 = 1	○
	By compare match/input capture B	○	○	—	○	○	○	CCLR1 = 1 CCLR0 = 0	○
	Syn-chronous clear	SYNC2 = 1	○	—	○	○	○	CCLR1 = 1 CCLR0 = 1	○
Phase counting mode		○	MDF = 1	○	○	○	○	○	—

[Legend] ○ : Setting available (valid).
— : Setting does not affect this mode.

Note: * The input capture function cannot be used in PWM mode. If compare match A and compare match B occur simultaneously, the compare match signal is inhibited.

Section 10 8-Bit Timers

10.1 Overview

The H8/3069R has a built-in 8-bit timer module with four channels (TMR0, TMR1, TMR2, and TMR3), based on 8-bit counters. Each channel has an 8-bit timer counter (8TCNT) and two 8-bit time constant registers (TCORA and TCORB) that are constantly compared with the 8TCNT value to detect compare match events. The timers can be used as multifunctional timers in a variety of applications, including the generation of a rectangular-wave output with an arbitrary duty cycle.

10.1.1 Features

The features of the 8-bit timer module are listed below.

- Selection of four clock sources
  The counters can be driven by one of three internal clock signals (φ/8, φ/64, or φ/8192) or an external clock input (enabling use as an external event counter).
- Selection of three ways to clear the counters
  The counters can be cleared on compare match A or B, or input capture B.
- Timer output controlled by two compare match signals
  The timer output signal in each channel is controlled by two independent compare match signals, enabling the timer to generate output waveforms with an arbitrary duty cycle or PWM output.
- A/D converter can be activated by a compare match
- Two channels can be cascaded
  - Channels 0 and 1 can be operated as the upper and lower halves of a 16-bit timer (16-bit count mode).
  - Channels 2 and 3 can be operated as the upper and lower halves of a 16-bit timer (16-bit count mode).
  - Channel 1 can count channel 0 compare match events (compare match count mode).
  - Channel 3 can count channel 2 compare match events (compare match count mode).
- Input capture function can be set
  8-bit or 16-bit input capture operation is available.

- Twelve interrupt sources

  There are twelve interrupt sources: four compare match sources, four compare match/input capture sources, four overflow sources.

  Two of the compare match sources and two of the combined compare match/input capture sources each have an independent interrupt vector. The remaining compare match interrupts, combined compare match/input capture interrupts, and overflow interrupts have one interrupt vector for two sources.

10.1.2 Block Diagram

The 8-bit timers are divided into two groups of two channels each: group 0 comprising channels 0 and 1, and group 1 comprising channels 2 and 3. Figure 10.1 shows a block diagram of 8-bit timer group 0.

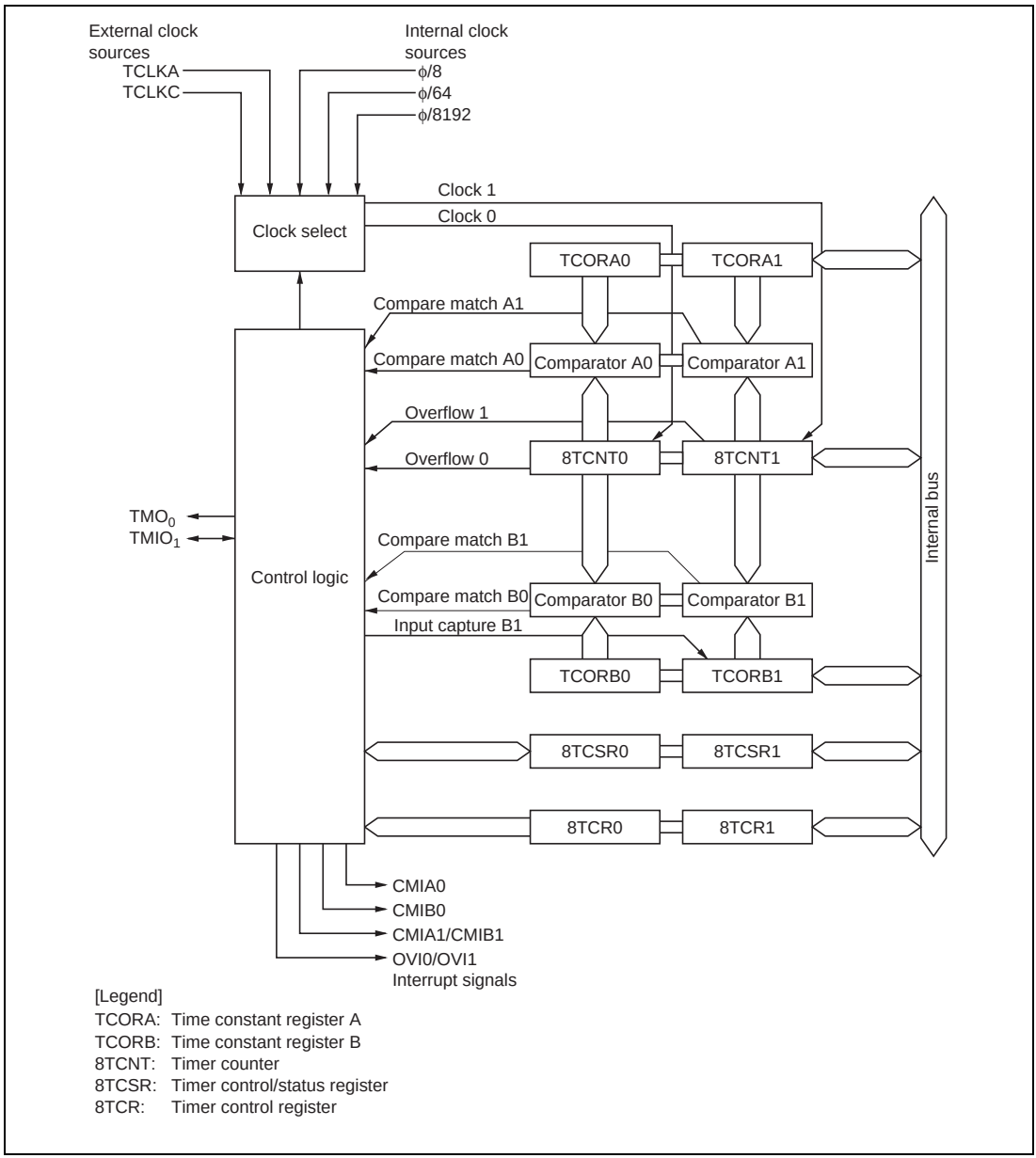


Figure 10.1 Block Diagram of 8-Bit Timer Unit (Two Channels: Group 0)

10.1.3 Pin Configuration

Table 10.1 summarizes the input/output pins of the 8-bit timer module.

Table 10.1 8-Bit Timer Pins

Group	Channel	Name	Abbreviation	I/O	Function
0	0	Timer output	TMO_0	Output	Compare match output
		Timer clock input	TCLKC	Input	Counter external clock input
	1	Timer input/output	$TMIO_1$	I/O	Compare match output/input capture input
		Timer clock input	TCLKA	Input	Counter external clock input
1	2	Timer output	TMO_2	Output	Compare match output
		Timer clock input	TCLKD	Input	Counter external clock input
	3	Timer input/output	$TMIO_3$	I/O	Compare match output/input capture input
		Timer clock input	TCLKB	Input	Counter external clock input

10.1.4 Register Configuration

Table 10.2 summarizes the registers of the 8-bit timer module.

Table 10.2 8-Bit Timer Registers

Channel	Address*[1]	Name	Abbreviation	R/W	Initial value
0	H'FFF80	Timer control register 0	8TCR0	R/W	H'00
	H'FFF82	Timer control/status register 0	8TCSR0	R/(W)*[2]	H'00
	H'FFF84	Time constant register A0	TCORA0	R/W	H'FF
	H'FFF86	Time constant register B0	TCORB0	R/W	H'FF
	H'FFF88	Timer counter 0	8TCNT0	R/W	H'00
1	H'FFF81	Timer control register 1	8TCR1	R/W	H'00
	H'FFF83	Timer control/status register 1	8TCSR1	R/(W)*[2]	H'00
	H'FFF85	Time constant register A1	TCORA1	R/W	H'FF
	H'FFF87	Time constant register B1	TCORB1	R/W	H'FF
	H'FFF89	Timer counter 1	8TCNT1	R/W	H'00
2	H'FFF90	Timer control register 2	8TCR2	R/W	H'00
	H'FFF92	Timer control/status register 2	8TCSR2	R/(W)*[2]	H'10
	H'FFF94	Time constant register A2	TCORA2	R/W	H'FF
	H'FFF96	Time constant register B2	TCORB2	R/W	H'FF
	H'FFF98	Timer counter 2	8TCNT2	R/W	H'00
3	H'FFF91	Timer control register 3	8TCR3	R/W	H'00
	H'FFF93	Timer control/status register 3	8TCSR3	R/(W)*[2]	H'00
	H'FFF95	Time constant register A3	TCORA3	R/W	H'FF
	H'FFF97	Time constant register B3	TCORB3	R/W	H'FF
	H'FFF99	Timer counter 3	8TCNT3	R/W	H'00

Notes: 1. Indicates the lower 20 bits of the address in advanced mode.
2. Only 0 can be written to bits 7 to 5, to clear these flags.

Each pair of registers for channel 0 and channel 1 comprises a 16-bit register with the channel 0 register as the upper 8 bits and the channel 1 register as the lower 8 bits, so they can be accessed together by word access.

Similarly, each pair of registers for channel 2 and channel 3 comprises a 16-bit register with the channel 2 register as the upper 8 bits and the channel 3 register as the lower 8 bits, so they can be accessed together by word access.

10.2 Register Descriptions

10.2.1 Timer Counters (8TCNT)

	8TCNT0								8TCNT1							
Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Initial value	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

	8TCNT2								8TCNT3							
Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Initial value	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

The timer counters (8TCNT) are 8-bit readable/writable up-counters that increment on pulses generated from an internal or external clock source. The clock source is selected by clock select bits 2 to 0 (CKS2 to CKS0) in the timer control register (8TCR). The CPU can always read or write to the timer counters.

The 8TCNT0 and 8TCNT1 pair, and the 8TCNT2 and 8TCNT3 pair, can each be accessed as a 16-bit register by word access.

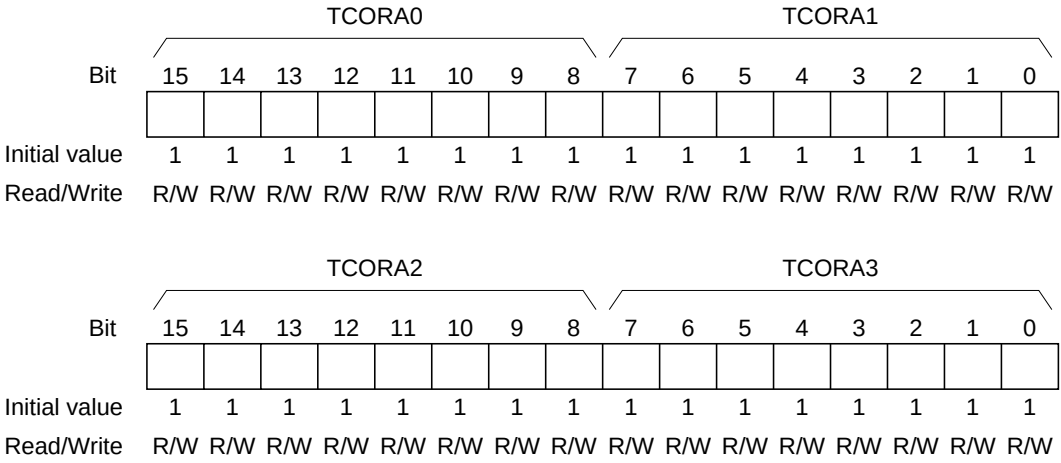
8TCNT can be cleared by an input capture signal or compare match signal. Counter clear bits 1 and 0 (CCLR1 and CCLR0) in 8TCR select the method of clearing.

When 8TCNT overflows from H'FF to H'00, the overflow flag (OVF) in the timer control/status register (8TCSR) is set to 1.

Each 8TCNT is initialized to H'00 by a reset and in standby mode.

10.2.2 Time Constant Registers A (TCORA)

TCORA0 to TCORA3 are 8-bit readable/writable registers.



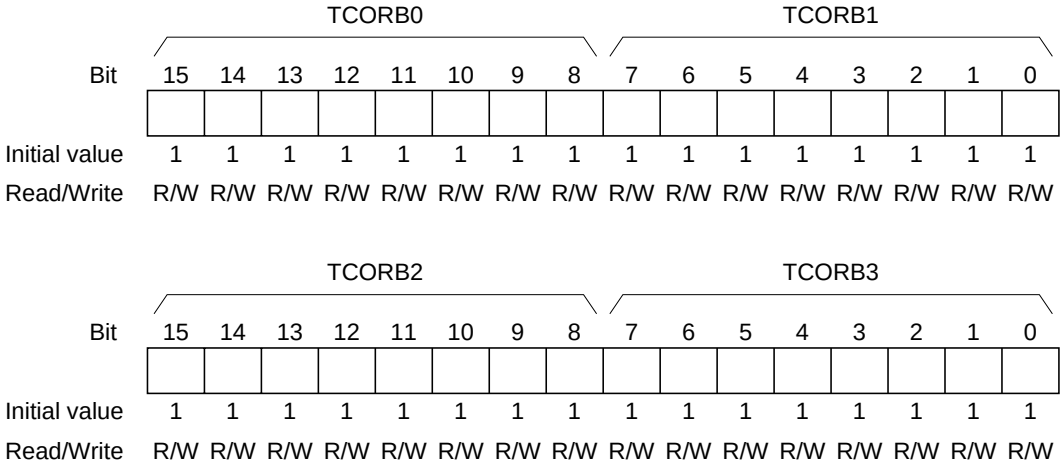
The TCORA0 and TCORA1 pair, and the TCORA2 and TCORA3 pair, can each be accessed as a 16-bit register by word access.

The TCORA value is constantly compared with the 8TCNT value. When a match is detected, the corresponding compare match flag A (CMFA) is set to 1 in 8TCSR.

The timer output can be freely controlled by these compare match signals and the settings of output select bits 1 and 0 (OS1, OS0) in 8TCSR.

Each TCORA register is initialized to H'FF by a reset and in standby mode.

10.2.3 Time Constant Registers B (TCORB)



TCORB0 to TCORB3 are 8-bit readable/writable registers. The TCORB0 and TCORB1 pair, and the TCORB2 and TCORB3 pair, can each be accessed as a 16-bit register by word access.

The TCORB value is constantly compared with the 8TCNT value. When a match is detected, the corresponding compare match flag B (CMFB) is set to 1 in 8TCSR*.

The timer output can be freely controlled by these compare match signals and the settings of output/input capture edge select bits 3 and 2 (OIS3, OIS2) in 8TCSR.

When TCORB is used for input capture, it stores the 8TCNT value on detection of an external input capture signal. At this time, the CMFB flag is set to 1 in the corresponding 8TCSR register. The detected edge of the input capture signal is set in 8TCSR.

Each TCORB register is initialized to H'FF by a reset and in standby mode.

Note: * When channel 1 and channel 3 are designated for TCORB input capture, the CMFB flag is not set by a channel 0 or channel 2 compare match B.

10.2.4 Timer Control Register (8TCR)

Bit	7	6	5	4	3	2	1	0
	CMIEB	CMIEA	OVIE	CCLR1	CCLR0	CKS2	CKS1	CKS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

8TCR is an 8-bit readable/writable register that selects the 8TCNT input clock, gives the 8TCNT clearing specification, and enables interrupt requests.

8TCR is initialized to H'00 by a reset and in standby mode.

For the timing, see section 10.4, Operation.

Bit 7—Compare Match Interrupt Enable B (CMIEB): Enables or disables the CMIB interrupt request when the CMFB flag is set to 1 in 8TCSR.

Bit 7 CMIEB	Description	
0	CMIB interrupt requested by CMFB is disabled	(Initial value)
1	CMIB interrupt requested by CMFB is enabled	

Bit 6—Compare Match Interrupt Enable A (CMIEA): Enables or disables the CMIA interrupt request when the CMFA flag is set to 1 in 8TCSR.

Bit 6 CMIEA	Description	
0	CMIA interrupt requested by CMFA is disabled	(Initial value)
1	CMIA interrupt requested by CMFA is enabled	

Bit 5—Timer Overflow Interrupt Enable (OVIE): Enables or disables the OVI interrupt request when the OVF flag is set to 1 in 8TCSR.

Bit 5 OVIE	Description	
0	OVI interrupt requested by OVF is disabled	(Initial value)
1	OVI interrupt requested by OVF is enabled	

Bits 4 and 3—Counter Clear 1 and 0 (CCLR1, CCLR0): These bits specify the 8TCNT clearing source. Compare match A or B, or input capture B, can be selected as the clearing source.

Bit 4 CCLR1	Bit 3 CCLR0	Description	
0	0	Clearing is disabled	(Initial value)
	1	Cleared by compare match A	
1	0	Cleared by compare match B/input capture B	
	1	Cleared by input capture B	

Note: When input capture B is set as the 8TCNT1 and 8TCNT3 counter clear source, 8TCNT0 and 8TCNT2 are not cleared by compare match B.

Bits 2 to 0—Clock Select 2 to 0 (CSK2 to CSK0): These bits select whether the clock input to 8TCNT is an internal or external clock.

Three internal clocks can be selected, all divided from the system clock (ϕ): ϕ/8, ϕ/64, and ϕ/8192. The rising edge of the selected internal clock triggers the count.

When use of an external clock is selected, three types of count can be selected: at the rising edge, the falling edge, and both rising and falling edges.

When CKS2, CKS1, CKS0 = 1, 0, 0, channels 0 and 1 and channels 2 and 3 are cascaded.

The incrementing clock source is different when 8TCR0 and 8TCR2 are set, and when 8TCR1 and 8TCR3 are set.

Bit 2 CSK2	Bit 1 CSK1	Bit 0 CSK0	Description
0	0	0	Clock input disabled (Initial value)
		1	Internal clock, counted on falling edge of ϕ/8
	1	0	Internal clock, counted on falling edge of ϕ/64
		1	Internal clock, counted on falling edge of ϕ/8192
1	0	0	Channel 0 (16-bit count mode): Count on 8TCNT1 overflow signal*[1] Channel 1 (compare match count mode): Count on 8TCNT0 compare match A*[1] Channel 2 (16-bit count mode): Count on 8TCNT3 overflow signal*[2] Channel 3 (compare match count mode): Count on 8TCNT2 compare match A*[2]
		1	External clock, counted on rising edge
	1	0	External clock, counted on falling edge
		1	External clock, counted on both rising and falling edges

Notes: 1. If the clock input of channel 0 is the 8TCNT1 overflow signal and that of channel 1 is the 8TCNT0 compare match signal, no incrementing clock is generated. Do not use this setting.

2. If the clock input of channel 2 is the 8TCNT3 overflow signal and that of channel 3 is the 8TCNT2 compare match signal, no incrementing clock is generated. Do not use this setting.

10.2.5 Timer Control/Status Registers (8TCSR)

8TCSR0

Bit	7	6	5	4	3	2	1	0
	CMFB	CMFA	OVF	ADTE	OIS3	OIS2	OS1	OS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/(W)*	R/(W)*	R/(W)*	R/W	R/W	R/W	R/W	R/W

8TCSR2

Bit	7	6	5	4	3	2	1	0
	CMFB	CMFA	OVF	—	OIS3	OIS2	OS1	OS0
Initial value	0	0	0	1	0	0	0	0
Read/Write	R/(W)*	R/(W)*	R/(W)*	—	R/W	R/W	R/W	R/W

8TCSR1, 8TCSR3

Bit	7	6	5	4	3	2	1	0
	CMFB	CMFA	OVF	ICE	OIS3	OIS2	OS1	OS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/(W)*	R/(W)*	R/(W)*	R/W	R/W	R/W	R/W	R/W

Note: * Only 0 can be written to bits 7 to 5, to clear these flags.

The timer control/status registers 8TCSR are 8-bit registers that indicate compare match/input capture and overflow statuses, and control compare match output/input capture edge selection.

8TCSR2 is initialized to H'10, and 8TCSR0, 8TCSR1, and 8TCSR3 to H'00, by a reset and in standby mode.

Bit 7—Compare Match/Input Capture Flag B (CMFB): Status flag that indicates the occurrence of a TCORB compare match or input capture.

Bit 7 CMFB	Description	
0	[Clearing condition] Read CMFB when CMFB = 1, then write 0 in CMFB	(Initial value)
1	[Setting conditions] • 8TCNT = TCORB* • The 8TCNT value is transferred to TCORB by an input capture signal when TCORB functions as an input capture register	

Note: * When bit ICE is set to 1 in 8TCSR1 and 8TCSR3, the CMFB flag is not set when 8TCNT0 = TCORB0 or 8TCNT2 = TCORB2.

Bit 6—Compare Match Flag A (CMFA): Status flag that indicates the occurrence of a TCORA compare match.

Bit 6 CMFA	Description	
0	[Clearing condition] Read CMFA when CMFA = 1, then write 0 in CMFA	(Initial value)
1	[Setting condition] 8TCNT = TCORA	

Bit 5—Timer Overflow Flag (OVF): Status flag that indicates that the 8TCNT has overflowed from H'FF to H'00.

Bit 5 OVF	Description	
0	[Clearing condition] Read OVF when OVF = 1, then write 0 in OVF	(Initial value)
1	[Setting condition] 8TCNT overflows from H'FF to H'00	

Bit 4—A/D Trigger Enable (ADTE) (In 8TCSR0): In combination with TRGE in the A/D control register (ADCR), enables or disables A/D converter start requests by compare match A or an external trigger.

TRGE*	Bit 4 ADTE	Description
0	0	A/D converter start requests by compare match A or external trigger pin ($\overline{\text{ADTRG}}$) input are disabled (Initial value)
	1	A/D converter start requests by compare match A or external trigger pin ($\overline{\text{ADTRG}}$) input are disabled
1	0	A/D converter start requests by external trigger pin ($\overline{\text{ADTRG}}$) input are enabled, and A/D converter start requests by compare match A are disabled
	1	A/D converter start requests by compare match A are enabled, and A/D converter start requests by external trigger pin ($\overline{\text{ADTRG}}$) input are disabled

Note: * TRGE is bit 7 of the A/D control register (ADCR).

Bit 4—Reserved (In 8TCSR1): This bit is a reserved bit, but can be read and written.

Bit 4—Input Capture Enable (ICE) (In 8TCSR1 and 8TCSR3): Selects the function of TCORB1 and TCORB3.

Bit 4 ICE	Description
0	TCORB1 and TCORB3 are compare match registers (Initial value)
1	TCORB1 and TCORB3 are input capture registers

When bit ICE is set to 1 in 8TCSR1 or 8TCSR3, the operation of the TCORA and TCORB registers in channels 0 to 3 is as shown in the tables below.

Table 10.3 Operation of Channels 0 and 1 when Bit ICE is Set to 1 in 8TCSR1 Register

Register	Register Function	Status Flag Change	Timer Output Capture Input	Interrupt Request
TCORA0	Compare match operation	CMFA changed from 0 to 1 in 8TCSR0 by compare match	TMO_0 output controllable	CMIA0 interrupt request generated by compare match
TCORB0	Compare match operation	CMFB not changed from 0 to 1 in 8TCSR0 by compare match	No output from TMO_0	CMIB0 interrupt request not generated by compare match
TCORA1	Compare match operation	CMFA changed from 0 to 1 in 8TCSR1 by compare match	$TMIO_1$ is dedicated input capture pin	CMIA1 interrupt request generated by compare match
TCORB1	Input capture operation	CMFB changed from 0 to 1 in 8TCSR1 by input capture	$TMIO_1$ is dedicated input capture pin	CMIB1 interrupt request generated by input capture

Table 10.4 Operation of Channels 2 and 3 when Bit ICE is Set to 1 in 8TCSR3 Register

Register	Register Function	Status Flag Change	Timer Output Capture Input	Interrupt Request
TCORA2	Compare match operation	CMFA changed from 0 to 1 in 8TCSR2 by compare match	TMO_2 output controllable	CMIA2 interrupt request generated by compare match
TCORB2	Compare match operation	CMFB not changed from 0 to 1 in 8TCSR2 by compare match	No output from TMO_2	CMIB2 interrupt request not generated by compare match
TCORA3	Compare match operation	CMFA changed from 0 to 1 in 8TCSR3 by compare match	$TMIO_3$ is dedicated input capture pin	CMIA3 interrupt request generated by compare match
TCORB3	Input capture operation	CMFB changed from 0 to 1 in 8TCSR3 by input capture	$TMIO_3$ is dedicated input capture pin	CMIB3 interrupt request generated by input capture

Bits 3 and 2—Output/Input Capture Edge Select B3 and B2 (OIS3, OIS2): In combination with the ICE bit in 8TCSR1 (8TCSR3), these bits select the compare match B output level or the input capture input detected edge.

The function of TCORB1 (TCORB3) depends on the setting of bit 4 of 8TCSR1 (8TCSR3).

ICE Bit in 8TCSR1 (8TCSR3)	Bit 3 OIS3	Bit 2 OIS2	Description	
0	0	0	No change when compare match B occurs	(Initial value)
		1	0 is output when compare match B occurs	
	1	0	1 is output when compare match B occurs	
		1	Output is inverted when compare match B occurs (toggle output)	
1	0	0	TCORB input capture on rising edge	
		1	TCORB input capture on falling edge	
	1	0	TCORB input capture on both rising and falling edges	
		1		

- When the compare match register function is used, the timer output priority order is: toggle output > 1 output > 0 output.
- If compare match A and B occur simultaneously, the output changes in accordance with the higher-priority compare match.
- When bits OIS3, OIS2, OS1, and OS0 are all cleared to 0, timer output is disabled.

Bits 1 and 0—Output Select A1 and A0 (OS1, OS0): These bits select the compare match A output level.

Bit 1 OS1	Bit 0 OS0	Description	
0	0	No change when compare match A occurs	(Initial value)
	1	0 is output when compare match A occurs	
1	0	1 is output when compare match A occurs	
	1	Output is inverted when compare match A occurs (toggle output)	

- When the compare match register function is used, the timer output priority order is: toggle output > 1 output > 0 output.
- If compare match A and B occur simultaneously, the output changes in accordance with the higher-priority compare match.
- When bits OIS3, OIS2, OS1, and OS0 are all cleared to 0, timer output is disabled.

10.3 CPU Interface

10.3.1 8-Bit Registers

8TCNT, TCORA, TCORB, 8TCR, and 8TCSR are 8-bit registers. These registers are connected to the CPU by an internal 16-bit data bus and can be read and written a word at a time or a byte at a time.

Figures 10.2 and 10.3 show the operation in word read and write accesses to 8TCNT.

Figures 10.4 to 10.7 show the operation in byte read and write accesses to 8TCNT0 and 8TCNT1.

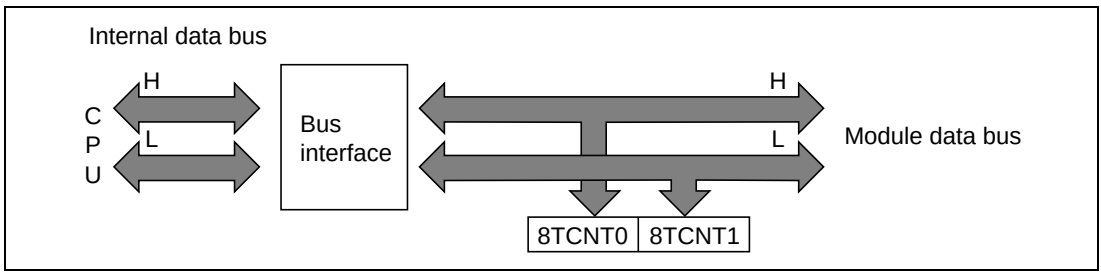


Figure 10.2 8TCNT Access Operation (CPU Writes to 8TCNT, Word)

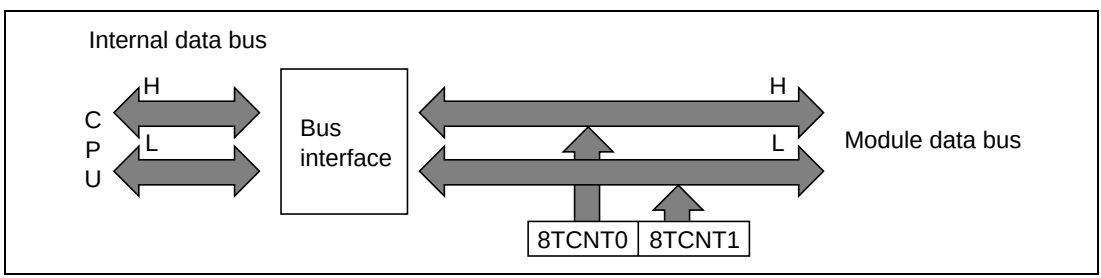


Figure 10.3 8TCNT Access Operation (CPU Reads 8TCNT, Word)

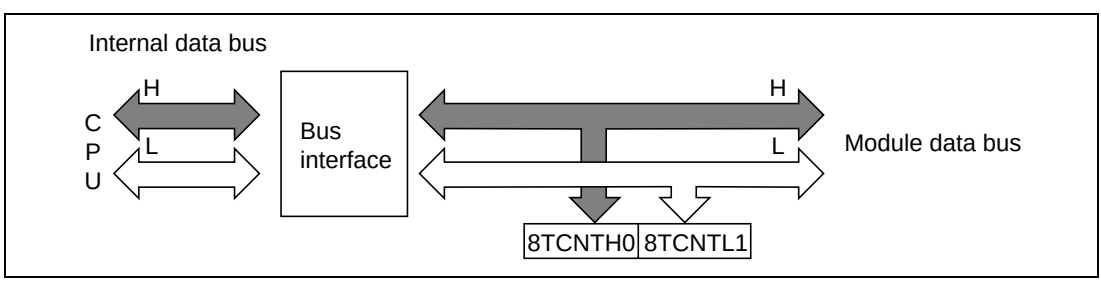


Figure 10.4 8TCNT0 Access Operation (CPU Writes to 8TCNT0, Upper Byte)

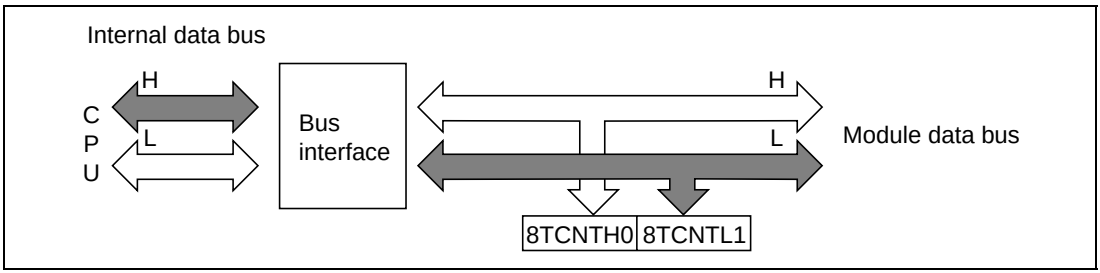


Figure 10.5 8TCNT1 Access Operation (CPU Writes to 8TCNT1, Lower Byte)

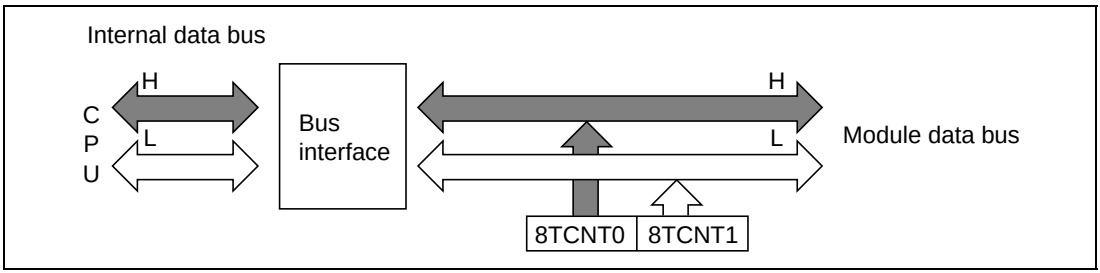


Figure 10.6 8TCNT0 Access Operation (CPU Reads 8TCNT0, Upper Byte)

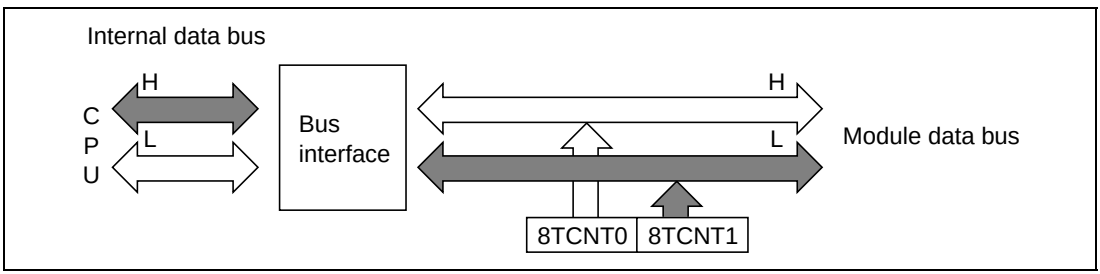


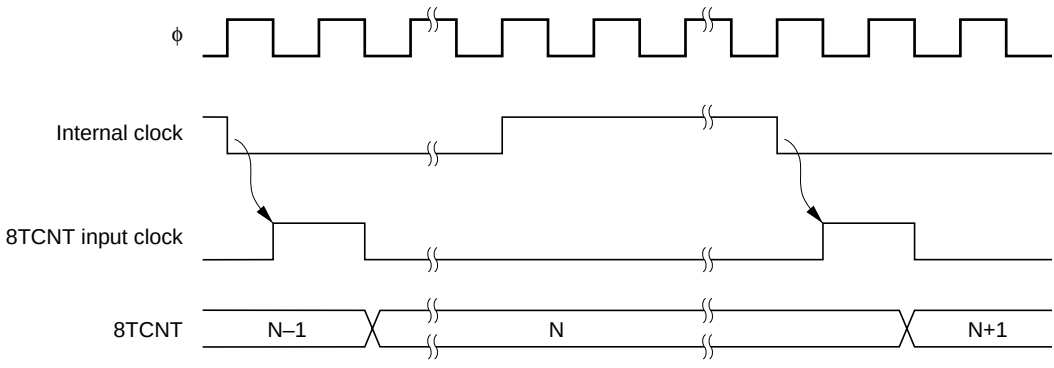
Figure 10.7 8TCNT1 Access Operation (CPU Reads 8TCNT1, Lower Byte)

10.4 Operation

10.4.1 8TCNT Count Timing

8TCNT is incremented by input clock pulses (either internal or external).

Internal Clock: Three different internal clock signals (ϕ/8, ϕ/64, or ϕ/8192) divided from the system clock (ϕ) can be selected, by setting bits CKS2 to CKS0 in 8TCR. Figure 10.8 shows the count timing.



Note: Even if the same internal clock is selected for the 16-bit timer and the 8-bit timer, the same operation will not be performed since the incrementing edge is different in each case.

Figure 10.8 Count Timing for Internal Clock Input

External Clock: Three incrementation methods can be selected by setting bits CKS2 to CKS0 in 8TCR: on the rising edge, the falling edge, and both rising and falling edges.

The pulse width of the external clock signal must be at least 1.5 system clocks when a single edge is selected, and at least 2.5 system clocks when both edges are selected. Shorter pulses will not be counted correctly.

Figure 10.9 shows the timing for incrementation on both edges of the external clock signal.

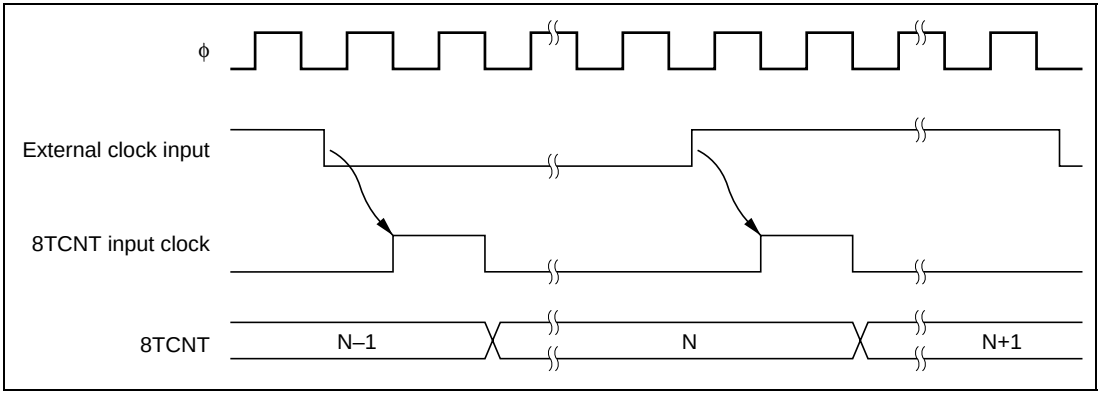


Figure 10.9 Count Timing for External Clock Input (Both-Edge Detection)

10.4.2 Compare Match Timing

Timer Output Timing: When compare match A or B occurs, the timer output is as specified by the OIS3, OIS2, OS1, and OS0 bits in 8TCSR (unchanged, 0 output, 1 output, or toggle output).

Figure 10.10 shows the timing when the output is set to toggle on compare match A.

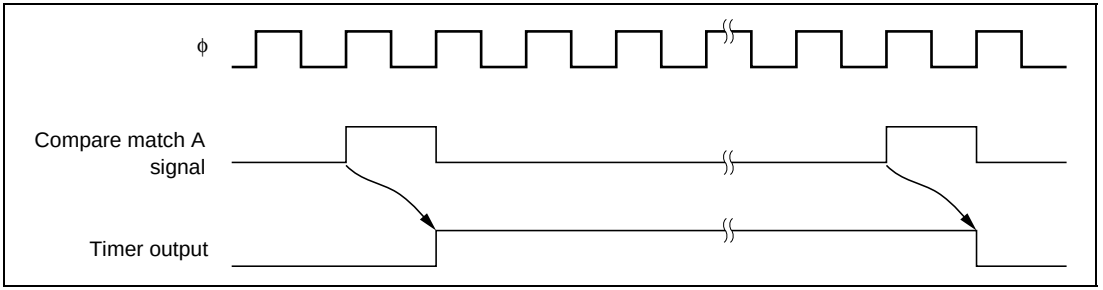


Figure 10.10 Timing of Timer Output

Clear by Compare Match: Depending on the setting of the CCLR1 and CCLR0 bits in 8TCR, 8TCNT can be cleared when compare match A or B occurs, Figure 10.11 shows the timing of this operation.

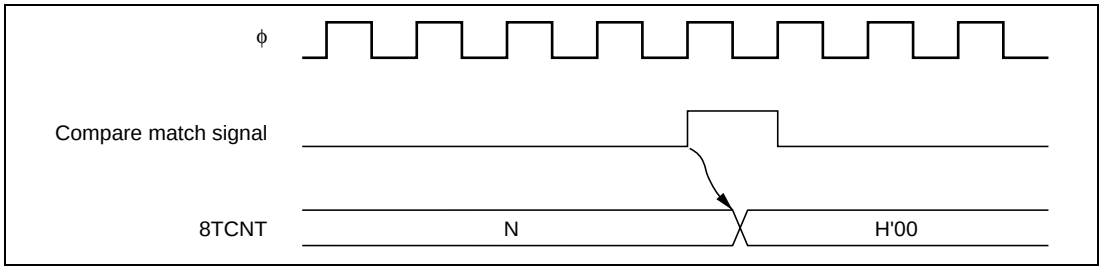


Figure 10.11 Timing of Clear by Compare Match

Clear by Input Capture: Depending on the setting of the CCLR1 and CCLR0 bits in 8TCR, 8TCNT can be cleared when input capture B occurs. Figure 10.12 shows the timing of this operation.

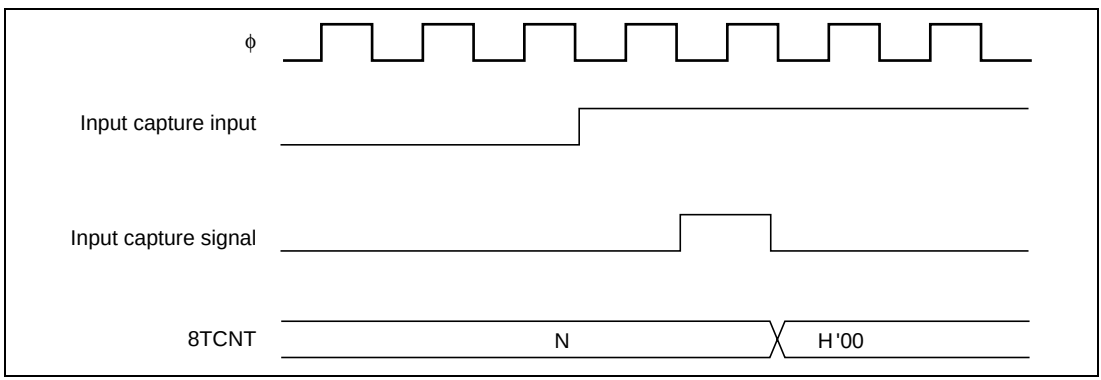


Figure 10.12 Timing of Clear by Input Capture

10.4.3 Input Capture Signal Timing

Input capture on the rising edge, falling edge, or both edges can be selected by settings in 8TCSR.

Figure 10.13 shows the timing when the rising edge is selected.

The pulse width of the input capture input signal must be at least 1.5 system clocks when a single edge is selected, and at least 2.5 system clocks when both edges are selected.

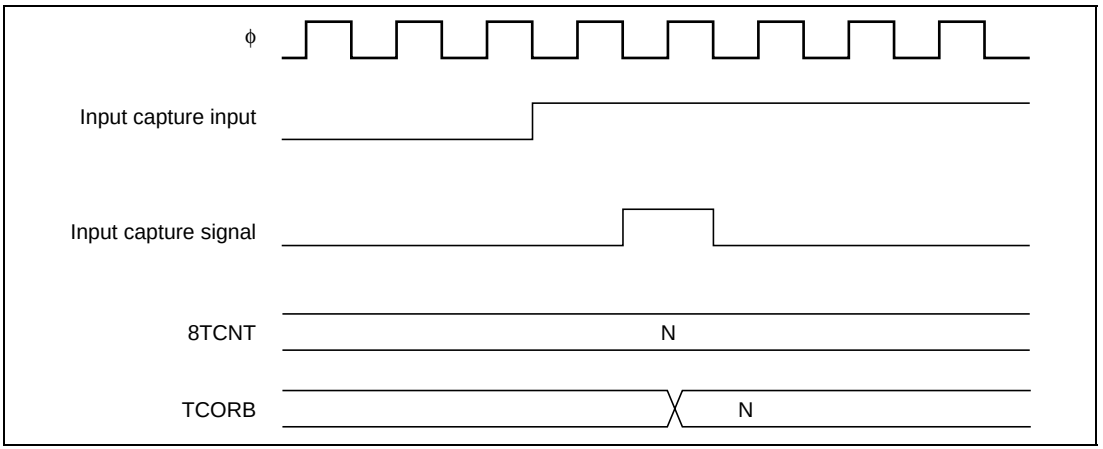


Figure 10.13 Timing of Input Capture Input Signal

10.4.4 Timing of Status Flag Setting

Timing of CMFA/CMFB Flag Setting when Compare Match Occurs: The CMFA and CMFB flags in 8TCSR are set to 1 by the compare match signal output when the TCORA or TCORB and 8TCNT values match. The compare match signal is generated in the last state of the match (when the matched 8TCNT count value is updated). Therefore, after the 8TCNT and TCORA or TCORB values match, the compare match signal is not generated until an incrementing clock pulse signal is generated. Figure 10.14 shows the timing in this case.

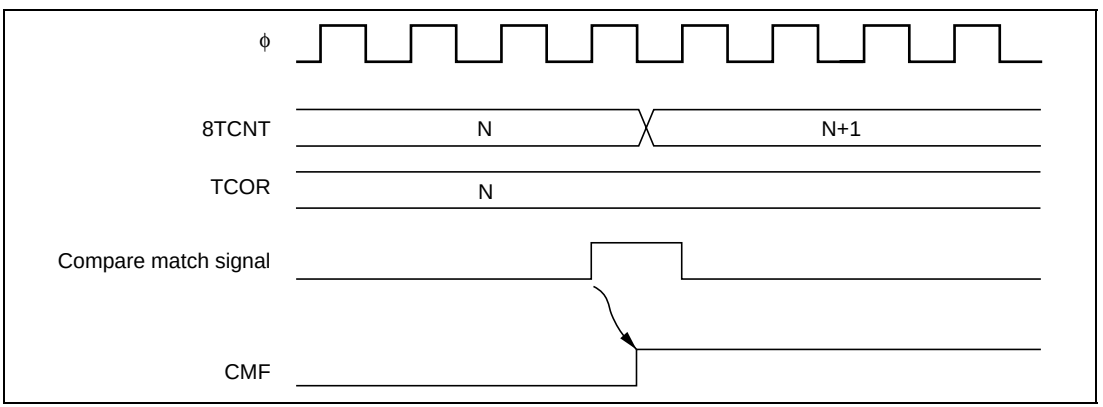


Figure 10.14 CMF Flag Setting Timing when Compare Match Occurs

Timing of CMFB Flag Setting when Input Capture Occurs: On generation of an input capture signal, the CMFB flag is set to 1 and at the same time the 8TCNT value is transferred to TCORB. Figure 10.15 shows the timing in this case.

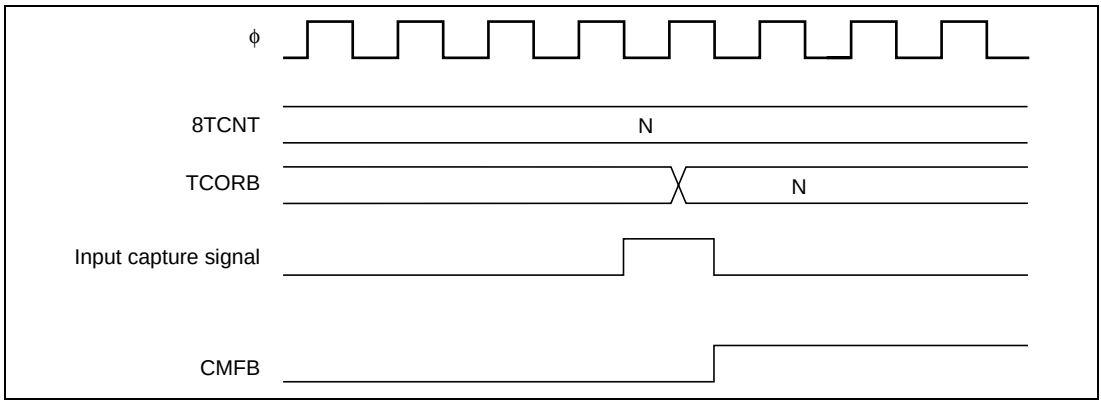


Figure 10.15 CMFB Flag Setting Timing when Input Capture Occurs

Timing of Overflow Flag (OVF) Setting: The OVF flag in 8TCSR is set to 1 by the overflow signal generated when 8TCNT overflows (from H'FF to H'00). Figure 10.16 shows the timing in this case.

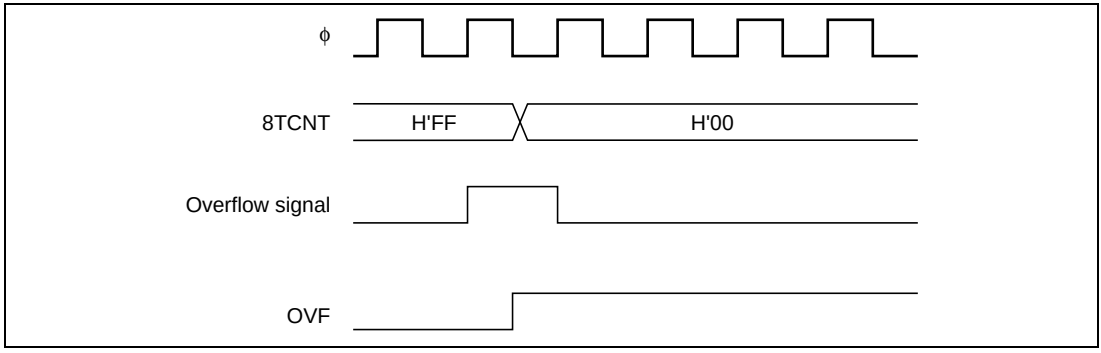


Figure 10.16 Timing of OVF Setting

10.4.5 Operation with Cascaded Connection

If bits CKS2 to CKS0 are set to (100) in either 8TCR0 or 8TCR1, the 8-bit timers of channels 0 and 1 are cascaded. With this configuration, the two timers can be used as a single 16-bit timer (16-bit timer mode), or channel 0 8-bit timer compare matches can be counted in channel 1 (compare match count mode). Similarly, if bits CKS2 to CKS0 are set to (100) in either 8TCR2 or 8TCR3, the 8-bit timers of channels 2 and 3 are cascaded. With this configuration, the two timers can be used as a single 16-bit timer (16-bit timer mode),or channel 2 8-bit timer compare matches can be counted in channel 3 (compare match count mode). In this case, the timer operates as below.

16-Bit Count Mode

- Channels 0 and 1:

  When bits CKS2 to CKS0 are set to (100) in 8TCR0, the timer functions as a single 16-bit timer with channel 0 occupying the upper 8 bits and channel 1 occupying the lower 8 bits.

  — Setting when Compare Match Occurs
    - The CMFA or CMFB flag is set to 1 in 8TCSR0 when a 16-bit compare match occurs.
    - The CMFA or CMFB flag is set to 1 in 8TCSR1 when a lower 8-bit compare match occurs.
    - TMO0 pin output control by bits OIS3, OIS2, OS1, and OS0 in 8TCSR0 is in accordance with the 16-bit compare match conditions.
    - TMIO1 pin output control by bits OIS3, OIS2, OS1, and OS0 in 8TCSR1 is in accordance with the lower 8-bit compare match conditions.

  — Setting when Input Capture Occurs
    - The CMFB flag is set to 1 in 8TCSR0 and 8TCSR1 when the ICE bit is 1 in TCSR1 and input capture occurs.
    - TMIO1 pin input capture input signal edge detection is selected by bits OIS3 and OIS2 in 8TCSR0.

  — Counter Clear Specification
    - If counter clear on compare match or input capture has been selected by the CCLR1 and CCLR0 bits in 8TCR0, the 16-bit counter (both 8TCNT0 and 8TCNT1) is cleared.
    - The settings of the CCLR1 and CCLR0 bits in 8TCR1 are ignored. The lower 8 bits cannot be cleared independently.

  — OVF Flag Operation
    - The OVF flag is set to 1 in 8TCSR0 when the 16-bit counter (8TCNT0 and 8TCNT1) overflows (from H'FFFF to H'0000).
    - The OVF flag is set to 1 in 8TCSR1 when the 8-bit counter (8TCNT1) overflows (from H'FF to H'00).

- Channels 2 and 3:

  When bits CKS2 to CKS0 are set to (100) in 8TCR2, the timer functions as a single 16-bit timer with channel 2 occupying the upper 8 bits and channel 3 occupying the lower 8 bits.

  — Setting when Compare Match Occurs
    - The CMFA or CMFB flag is set to 1 in 8TCSR2 when a 16-bit compare match occurs.
    - The CMFA or CMFB flag is set to 1 in 8TCSR3 when a lower 8-bit compare match occurs.
    - TMO2 pin output control by bits OIS3, OIS2, OS1, and OS0 in 8TCSR2 is in accordance with the 16-bit compare match conditions.
    - TMIO3 pin output control by bits OIS3, OIS2, OS1, and OS0 in 8TCSR3 is in accordance with the lower 8-bit compare match conditions.

— Setting when Input Capture Occurs
  - The CMFB flag is set to 1 in 8TCSR2 and 8TCSR3 when the ICE bit is 1 in TCSR3 and input capture occurs.
  - TMIO3 pin input capture input signal edge detection is selected by bits OIS3 and OIS2 in 8TCSR2.

— Counter Clear Specification
  - If counter clear on compare match has been selected by the CCLR1 and CCLR0 bits in 8TCR2, the 16-bit counter (both 8TCNT2 and 8TCNT3) is cleared.
  - The settings of the CCLR1 and CCLR0 bits in 8TCR3 are ignored. The lower 8 bits cannot be cleared independently.

— OVF Flag Operation
  - The OVF flag is set to 1 in 8TCSR2 when the 16-bit counter (8TCNT2 and 8TCNT3) overflows (from H'FFFF to H'0000).
  - The OVF flag is set to 1 in 8TCSR3 when the 8-bit counter (8TCNT3) overflows (from H'FF to H'00).

Compare Match Count Mode

- Channels 0 and 1:

  When bits CKS2 to CKS0 are set to (100) in 8TCR1, 8TCNT1 counts channel 0 compare match A events.

  CMF flag setting, interrupt generation, TMO pin output, counter clearing, and so on, is in accordance with the settings for each channel.

  Note: When bit ICE = 1 in 8TCSR1, the compare match register function of TCORB0 in channel 0 cannot be used.

- Channels 2 and 3:

  When bits CKS2 to CKS0 are set to (100) in 8TCR3, 8TCNT3 counts channel 2 compare match A events.

  CMF flag setting, interrupt generation, TMO pin output, counter clearing, and so on, is in accordance with the settings for each channel.

Caution

Do not set 16-bit counter mode and compare match count mode simultaneously within the same group, as the 8TCNT input clock will not be generated and the counters will not operate.

10.4.6 Input Capture Setting

The 8TCNT value can be transferred to TCORB on detection of an input edge on the input capture/output compare pin ($TMIO_1$ or $TMIO_3$). Rising edge, falling edge, or both edge detection can be selected. In 16-bit count mode, 16-bit input capture can be used.

Setting Input Capture Operation in 8-Bit Timer Mode (Normal Operation)

- Channel 1:
  - Set TCORB1 as an 8-bit input capture register with the ICE bit in 8TCSR1.
  - Select rising edge, falling edge, or both edges as the input edge(s) for the input capture signal ($TMIO_1$) with bits OIS3 and OIS2 in 8TCSR1.
  - Select the input clock with bits CKS2 to CKS0 in 8TCR1, and start the 8TCNT count.
- Channel 3:
  - Set TCORB3 as an 8-bit input capture register with the ICE bit in 8TCSR3.
  - Select rising edge, falling edge, or both edges as the input edge(s) for the input capture signal ($TMIO_3$) with bits OIS3 and OIS2 in 8TCSR3.
  - Select the input clock with bits CKS2 to CKS0 in 8TCR3, and start the 8TCNT count.

Note: When TCORB1 in channel 1 is used for input capture, TCORB0 in channel 0 cannot be used as a compare match register.
Similarly, when TCORB3 in channel 3 is used for input capture, TCORB2 in channel 2 cannot be used as a compare match register.

Setting Input Capture Operation in 16-Bit Count Mode

- Channels 0 and 1:
  - In 16-bit count mode, TCORB0 and TCORB1 function as a 16-bit input capture register when the ICE bit is set to 1 in 8TCSR1.
  - Select rising edge, falling edge, or both edges as the input edge(s) for the input capture signal ($TMIO_1$) with bits OIS3 and OIS2 in 8TCSR0. (In 16-bit count mode, the settings of bits OIS3 and OIS2 in 8TCSR1 are ignored.)
  - Select the input clock with bits CKS2 to CKS0 in 8TCR1, and start the 8TCNT count.
- Channels 2 and 3:
  - In 16-bit count mode, TCORB2 and TCORB3 function as a 16-bit input capture register when the ICE bit is set to 1 in 8TCSR3.
  - Select rising edge, falling edge, or both edges as the input edge(s) for the input capture signal ($TMIO_3$) with bits OIS3 and OIS2 in 8TCSR2. (In 16-bit count mode, the settings of bits OIS3 and OIS2 in 8TCSR3 are ignored.)
  - Select the input clock with bits CKS2 to CKS0 in 8TCR3, and start the 8TCNT count.

10.5 Interrupt

10.5.1 Interrupt Sources

The 8-bit timer unit can generate three types of interrupt: compare match A and B (CMIA and CMIB) and overflow (TOVI). Table 10.5 shows the interrupt sources and their priority order. Each interrupt source is enabled or disabled by the corresponding interrupt enable bit in 8TCR. A separate interrupt request signal is sent to the interrupt controller by each interrupt source.

Table 10.5 Types of 8-Bit Timer Interrupt Sources and Priority Order

Interrupt Source	Description	Priority
CMIA	Interrupt by CMFA	High
CMIB	Interrupt by CMFB	↑
TOVI	Interrupt by OVF	Low

For compare match interrupts (CMIA1/CMIB1 and CMIA3/CMIB3) and the overflow interrupts (TOVI0/TOVI1 and TOVI2/TOVI3), one vector is shared by two interrupts.

Table 10.6 lists the interrupt sources.

Table 10.6 8-Bit Timer Interrupt Sources

Channel	Interrupt Source	Description
0	CMIA0	TCORA0 compare match
	CMIB0	TCORB0 compare match/input capture
1	CMIA1/CMIB1	TCORA1 compare match, or TCORB1 compare match/input capture
0, 1	TOVI0/TOVI1	Counter 0 or counter 1 overflow
2	CMIA2	TCORA2 compare match
	CMIB2	TCORB2 compare match/input capture
3	CMIA3/CMIB3	TCORA3 compare match, or TCORB3 compare match/input capture
2, 3	TOVI2/TOVI3	Counter 2 or counter 3 overflow

10.5.2 A/D Converter Activation

The A/D converter can only be activated by channel 0 compare match A.

If the ADTE bit setting is 1 when the CMFA flag in 8TCSR0 is set to 1 by generation of channel 0 compare match A, an A/D conversion start request will be issued to the A/D converter. If the TRGE bit in ADCR is 1 at this time, the A/D converter will be started. If the ADTE bit in 8TCSR0 is 1, A/D converter external trigger pin ($\overline{\text{ADTRG}}$) input is disabled.

10.6 8-Bit Timer Application Example

Figure 10.17 shows how the 8-bit timer module can be used to output pulses with any desired duty cycle. The settings for this example are as follows:

- Clear the CCLR1 bit to 0 and set the CCLR0 bit to 1 in 8TCR so that 8TCNT is cleared by a TCORA compare match.
- Set bits OIS3, OIS2, OS1, and OS0 to (0110) in 8TCSR so that 1 is output on a TCORA compare match and 0 is output on a TCORB compare match.

The above settings enable a waveform with the cycle determined by TCORA and the pulse width detected by TCORB to be output without software intervention.

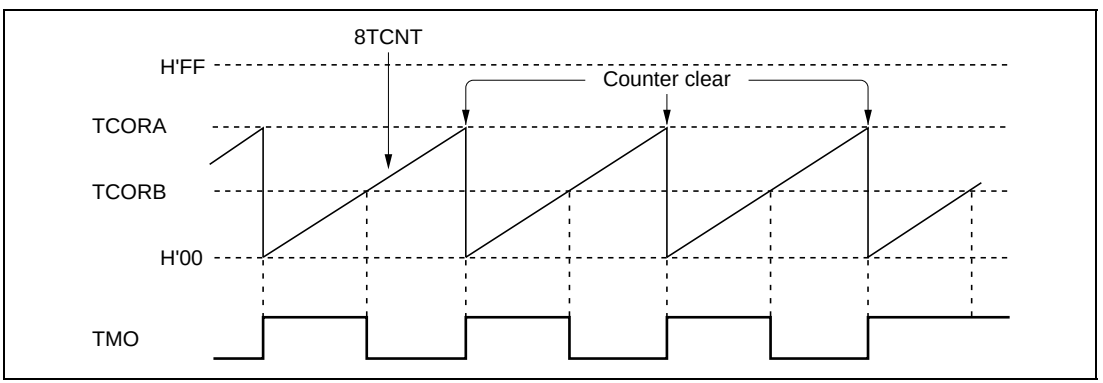


Figure 10.17 Example of Pulse Output

10.7 Usage Notes

Note that the following kinds of contention can occur in 8-bit timer operation.

10.7.1 Contention between 8TCNT Write and Clear

If a timer counter clear signal occurs in the T_3 state of a 8TCNT write cycle, clearing of the counter takes priority and the write is not performed. Figure 10.18 shows the timing in this case.

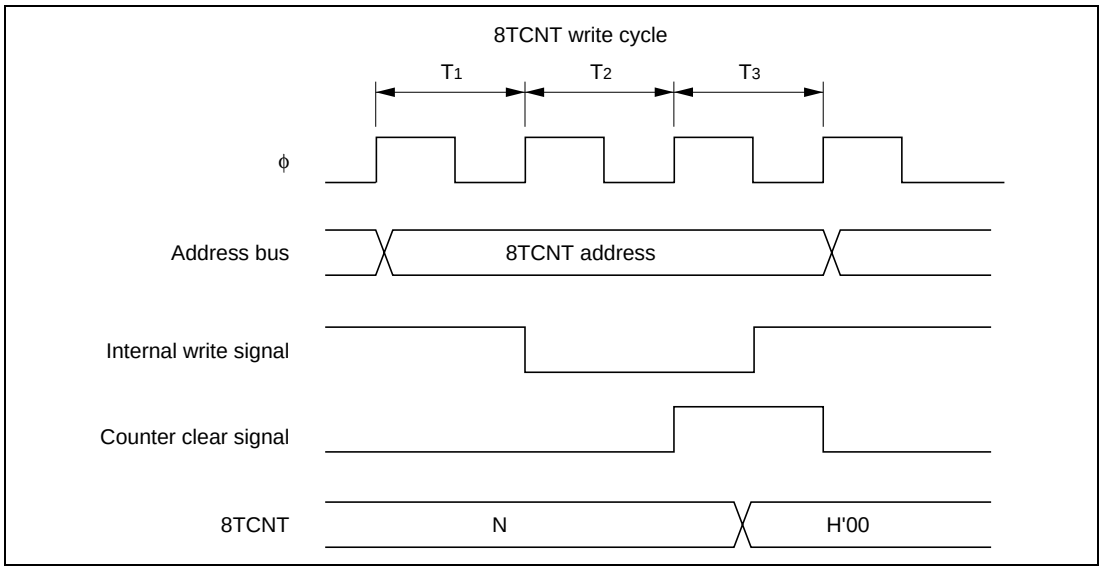


Figure 10.18 Contention between 8TCNT Write and Clear

10.7.2 Contention between 8TCNT Write and Increment

If an increment pulse occurs in the T_3 state of a 8TCNT write cycle, writing takes priority and 8TCNT is not incremented. Figure 10.19 shows the timing in this case.

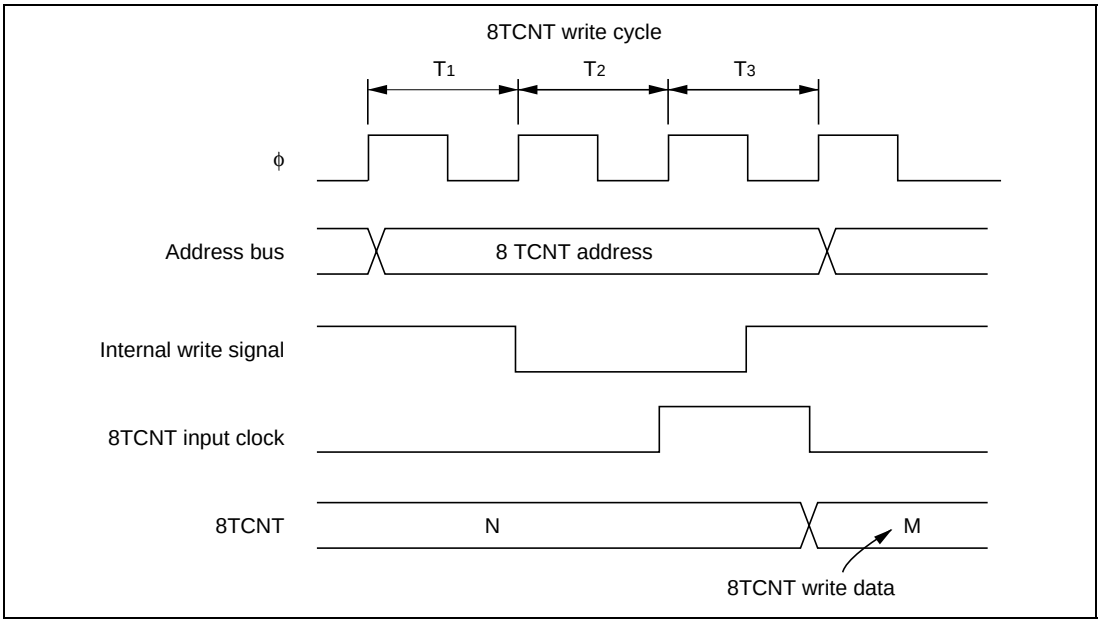


Figure 10.19 Contention between 8TCNT Write and Increment

10.7.3 Contention between TCOR Write and Compare Match

If a compare match occurs in the T_3 state of a TCOR write cycle, writing takes priority and the compare match signal is inhibited. Figure 10.20 shows the timing in this case.

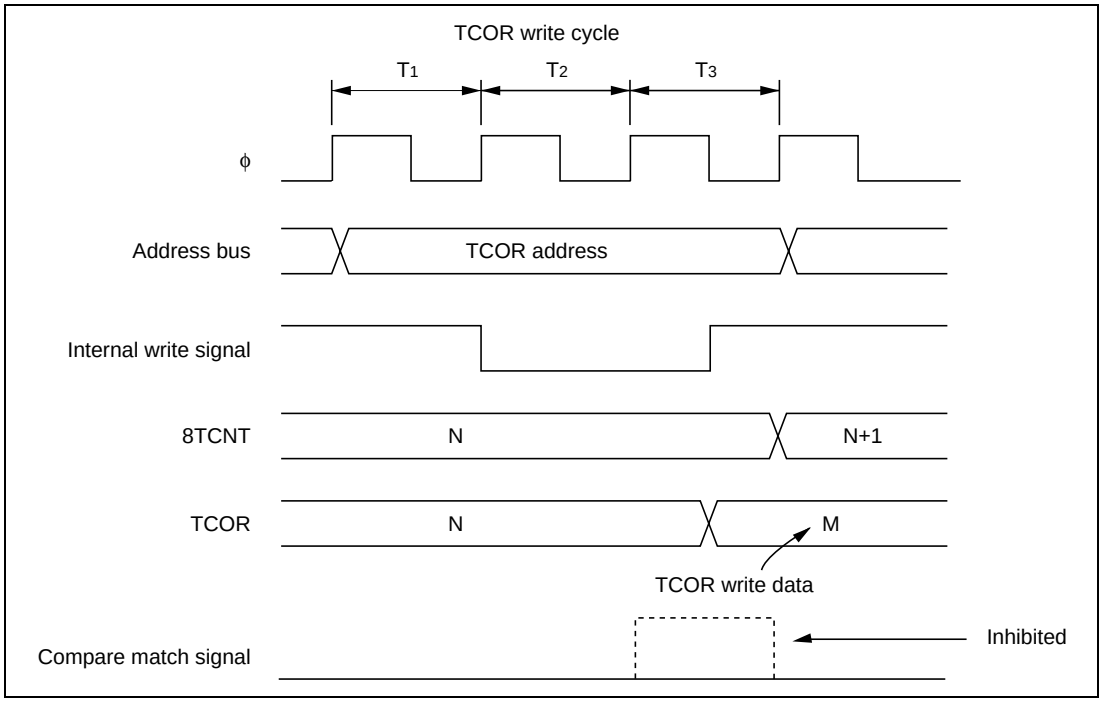


Figure 10.20 Contention between TCOR Write and Compare Match

10.7.4 Contention between TCOR Read and Input Capture

If an input capture signal occurs in the T_3 state of a TCOR read cycle, the value before input capture is read. Figure 10.21 shows the timing in this case.

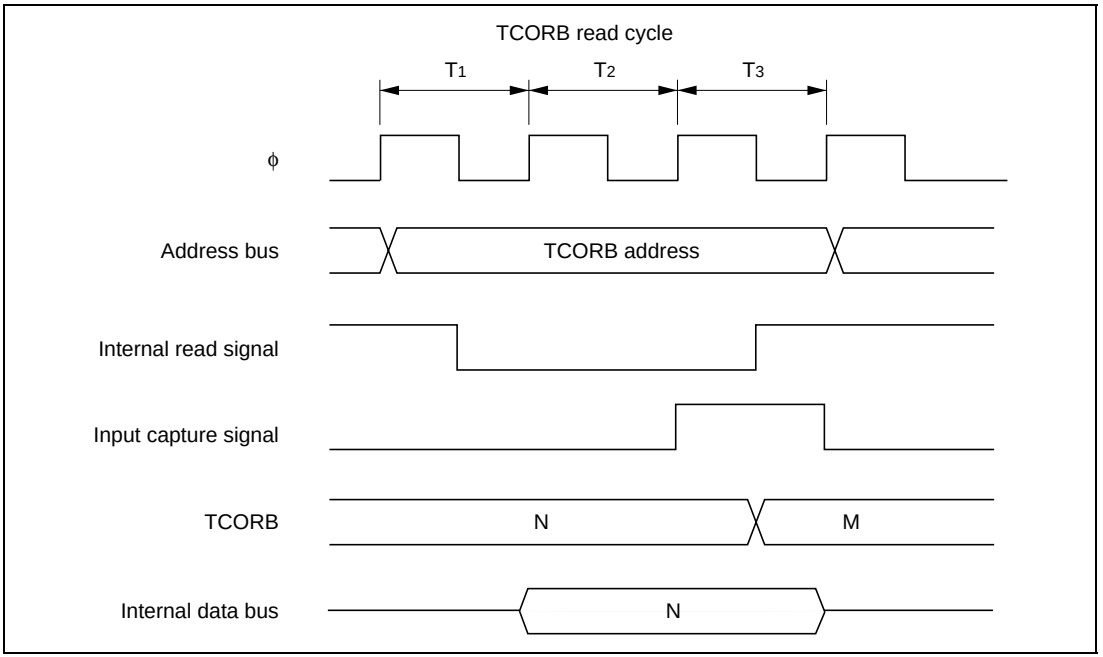


Figure 10.21 Contention between TCOR Read and Input Capture

10.7.5 Contention between Counter Clearing by Input Capture and Counter Increment

If an input capture signal and counter increment signal occur simultaneously, counter clearing by the input capture signal takes priority and the counter is not incremented. The value before the counter is cleared is transferred to TCORB. Figure 10.22 shows the timing in this case.

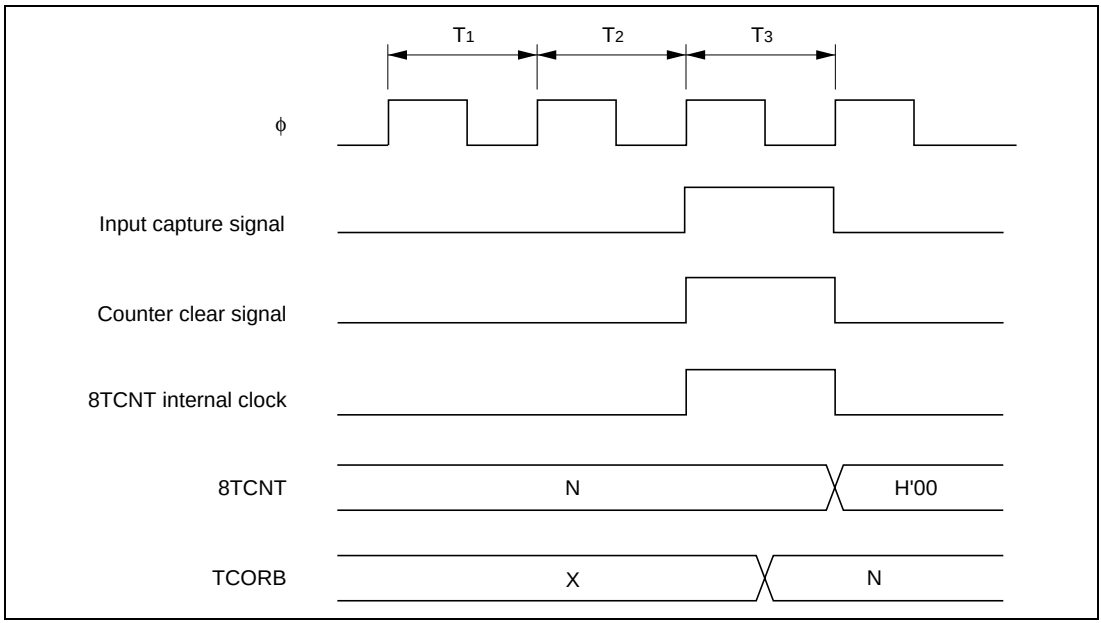


Figure 10.22 Contention between Counter Clearing by Input Capture and Counter Increment

10.7.6 Contention between TCOR Write and Input Capture

If an input capture signal occurs in the T_3 state of a TCOR write cycle, input capture takes priority and the write to TCOR is not performed. Figure 10.23 shows the timing in this case.

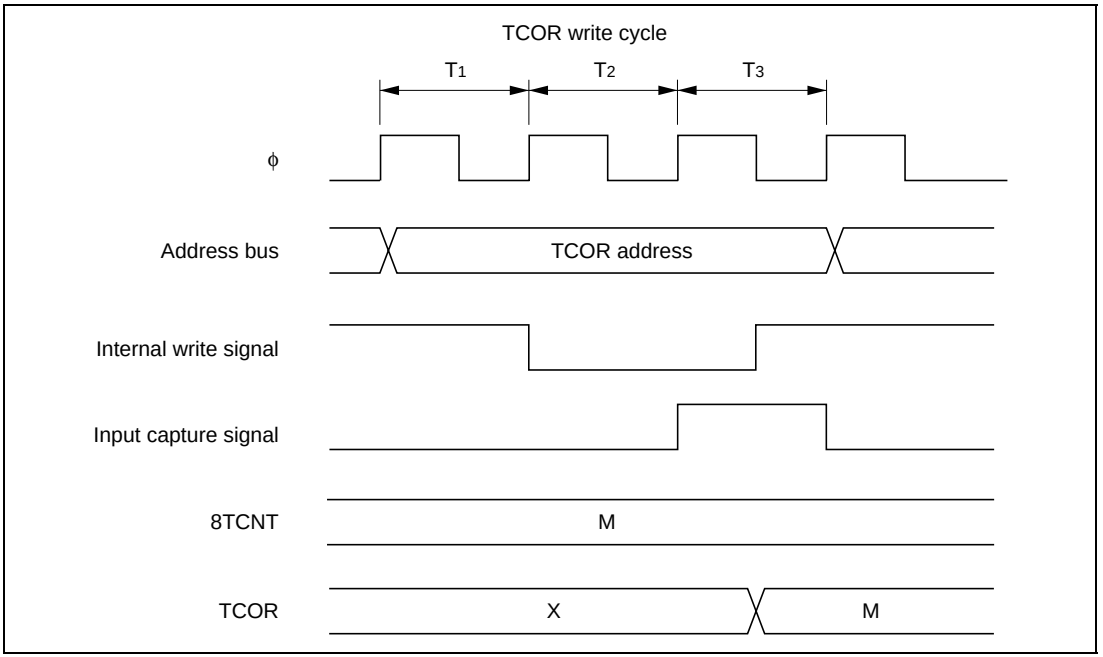


Figure 10.23 Contention between TCOR Write and Input Capture

10.7.7 Contention between 8TCNT Byte Write and Increment in 16-Bit Count Mode (Cascaded Connection)

If an increment pulse occurs in the T_3 state of an 8TCNT byte write cycle in 16-bit count mode, the counter write takes priority and the byte data for which the write was performed is not incremented. The byte data for which a write was not performed is incremented. Figure 10.24 shows the timing when an increment pulse occurs in the T_2 state of a byte write to 8TCNT (upper byte). If an increment pulse occurs in the T_2 state, on the other hand, the increment takes priority.

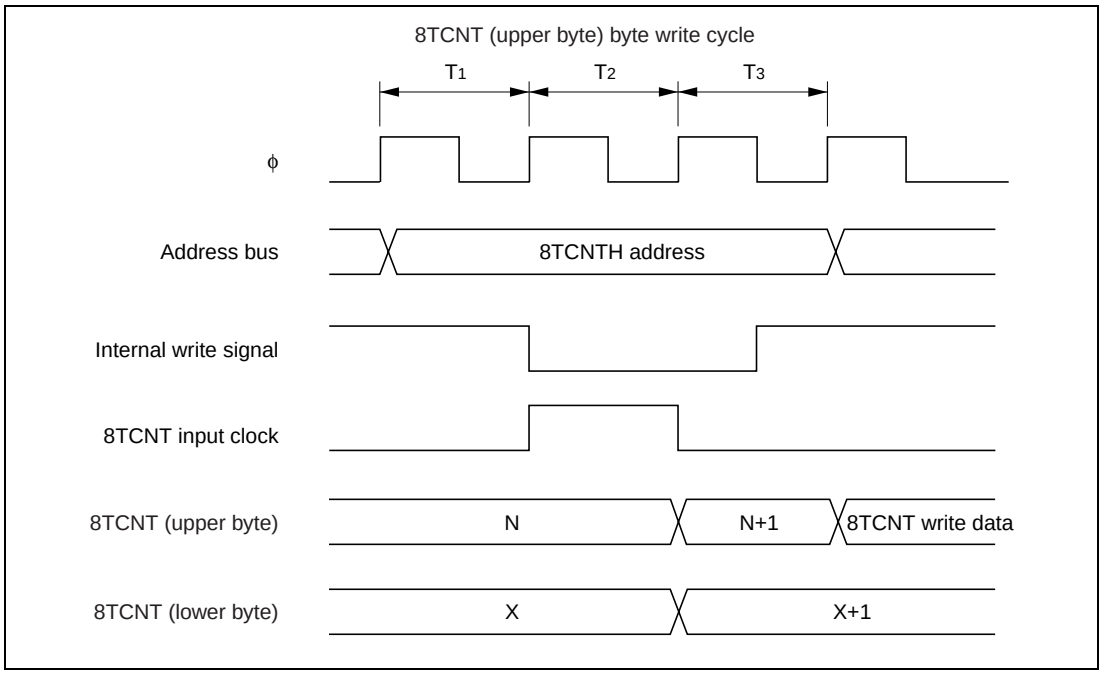


Figure 10.24 Contention between 8TCNT Byte Write and Increment in 16-Bit Count Mode

10.7.8 Contention between Compare Matches A and B

If compare matches A and B occur at the same time, the 8-bit timer operates according to the relative priority of the output states set for compare match A and compare match B, as shown in Table 10.7.

Table 10.7 Timer Output Priority Order

Output Setting	Priority
Toggle output	High
1 output	↑
0 output	
No change	Low

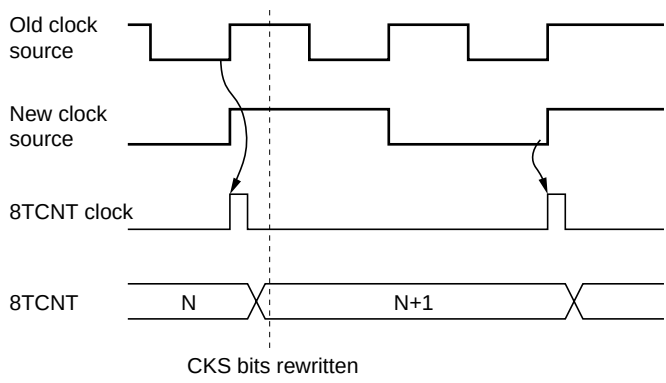
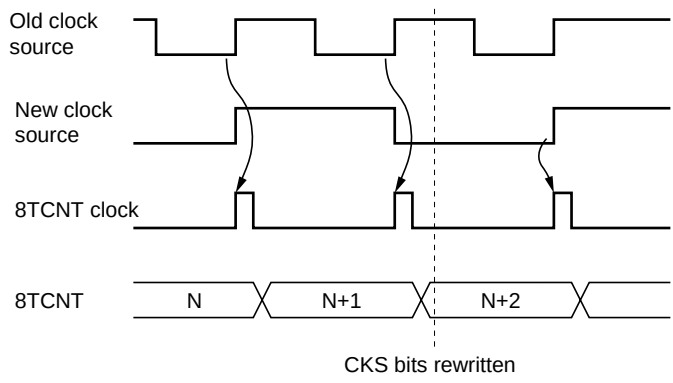
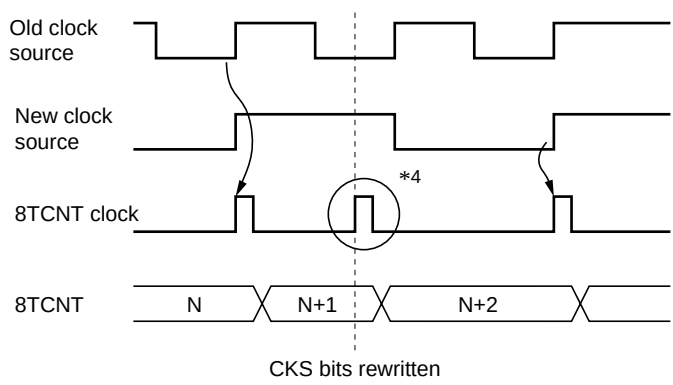
10.7.9 8TCNT Operation and Internal Clock Source Switchover

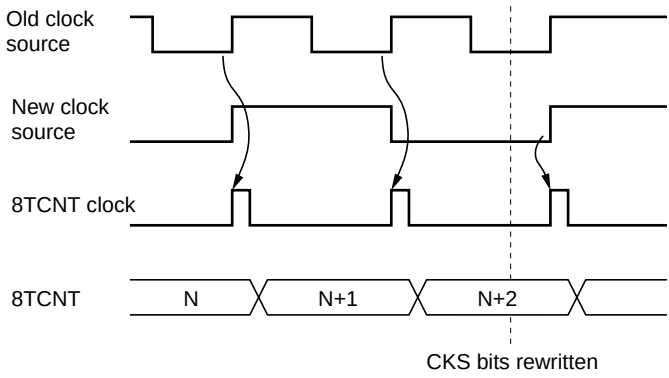
Switching internal clock sources may cause 8TCNT to increment, depending on the switchover timing. Table 10.8 shows the relation between the time of the switchover (by writing to bits CKS1 and CKS0) and the operation of 8TCNT.

The 8TCNT input clock is generated from the internal clock source by detecting the rising edge of the internal clock. If a switchover is made from a low clock source to a high clock source, as in case No. 3 in Table 10.8, the switchover will be regarded as a falling edge, a 8TCNT clock pulse will be generated, and 8TCNT will be incremented.

8TCNT may also be incremented when switching between internal and external clocks.

Table 10.8 Internal Clock Switchover and 8TCNT Operation

No.	CKS1 and CKS0 Write Timing	8TCNT Operation
1	High → high switchover*[1]	
2	High → low switchover*[2]	
3	Low → high switchover*[3]	

No.	CKS1 and CKS0 Write Timing	8TCNT Operation
4	Low → low switchover*[4]	

Notes: 1. Including switchovers from the high level to the halted state, and from the halted state to the high level.
2. Including switchover from the halted state to the low level.
3. Including switchover from the low level to the halted state.
4. The switchover is regarded as a rising edge, causing 8TCNT to increment.

Section 11 Programmable Timing Pattern Controller (TPC)

11.1 Overview

The H8/3069R has a built-in programmable timing pattern controller (TPC) that provides pulse outputs by using the 16-bit timer as a time base. The TPC pulse outputs are divided into 4-bit groups (group 3 to group 0) that can operate simultaneously and independently.

11.1.1 Features

TPC features are listed below.

- 16-bit output data
  Maximum 16-bit data can be output. TPC output can be enabled on a bit-by-bit basis.
- Four output groups
  Output trigger signals can be selected in 4-bit groups to provide up to four different 4-bit outputs.
- Selectable output trigger signals
  Output trigger signals can be selected for each group from the compare match signals of three 16-bit timer channels.
- Non-overlap mode
  A non-overlap margin can be provided between pulse outputs.
- Can operate together with the DMA controller (DMAC)
  The compare-match signals selected as trigger signals can activate the DMAC for sequential output of data without CPU intervention.

11.1.2 Block Diagram

Figure 11.1 shows a block diagram of the TPC.

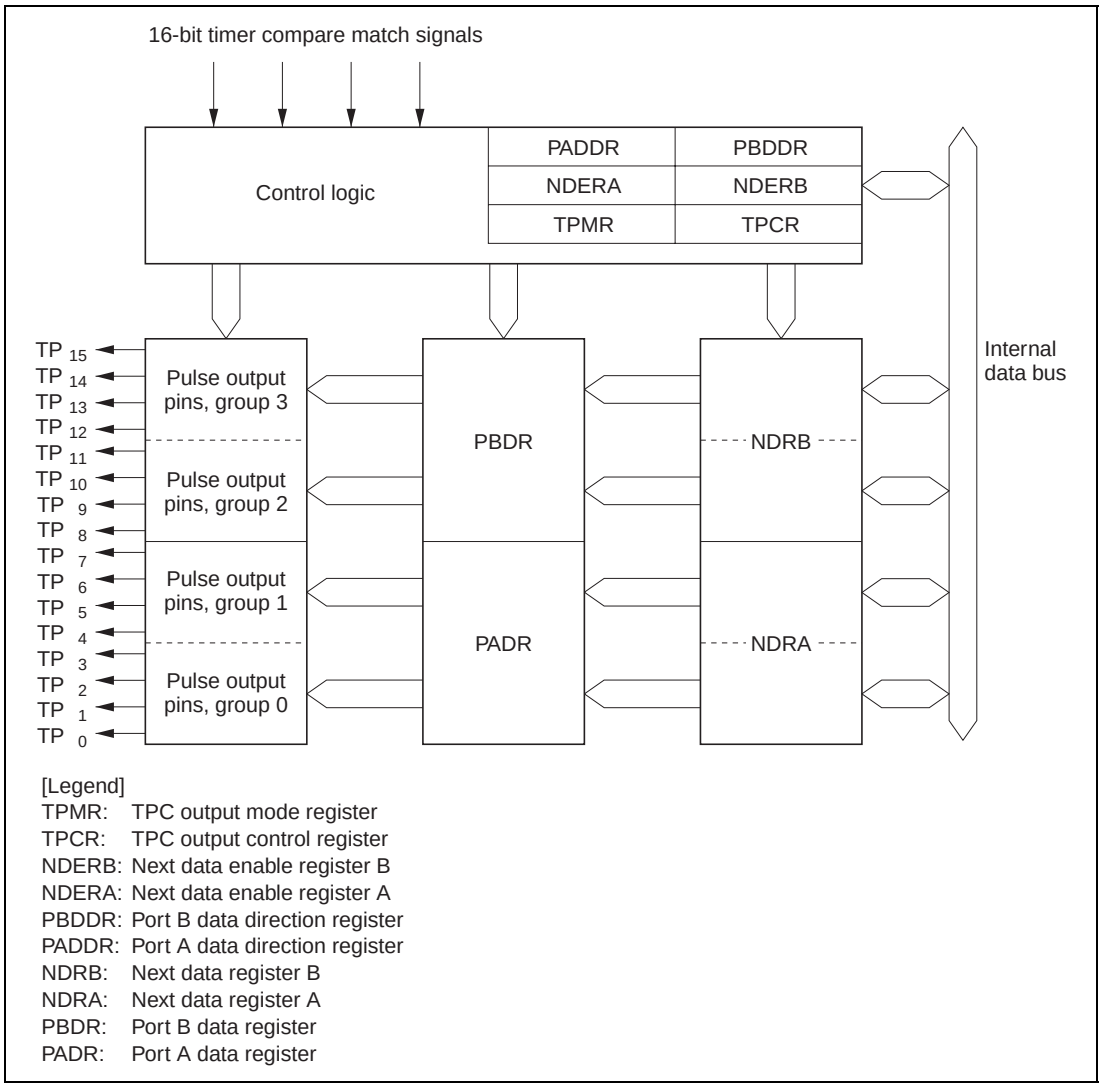


Figure 11.1 TPC Block Diagram

11.1.3 TPC Pins

Table 11.1 summarizes the TPC output pins.

Table 11.1 TPC Pins

Name	Symbol	I/O	Function
TPC output 0	TP_0	Output	Group 0 pulse output
TPC output 1	TP_1	Output	
TPC output 2	TP_2	Output	
TPC output 3	TP_3	Output	
TPC output 4	TP_4	Output	Group 1 pulse output
TPC output 5	TP_5	Output	
TPC output 6	TP_6	Output	
TPC output 7	TP_7	Output	
TPC output 8	TP_8	Output	Group 2 pulse output
TPC output 9	TP_9	Output	
TPC output 10	TP_{10}	Output	
TPC output 11	TP_{11}	Output	
TPC output 12	TP_{12}	Output	Group 3 pulse output
TPC output 13	TP_{13}	Output	
TPC output 14	TP_{14}	Output	
TPC output 15	TP_{15}	Output	

11.1.4 Registers

Table 11.2 summarizes the TPC registers.

Table 11.2 TPC Registers

Address*[1]	Name	Abbreviation	R/W	Function
H'EE009	Port A data direction register	PADDR	W	H'00
H'FFFD9	Port A data register	PADR	R/(W)*[2]	H'00
H'EE00A	Port B data direction register	PBDDR	W	H'00
H'FFFDA	Port B data register	PBDR	R/(W)*[2]	H'00
H'FFFA0	TPC output mode register	TPMR	R/W	H'F0
H'FFFA1	TPC output control register	TPCR	R/W	H'FF
H'FFFA2	Next data enable register B	NDERB	R/W	H'00
H'FFFA3	Next data enable register A	NDERA	R/W	H'00
H'FFFA5/ H'FFFA7*[3]	Next data register A	NDRA	R/W	H'00
H'FFFA4/ H'FFFA6*[3]	Next data register B	NDRB	R/W	H'00

Notes: 1. Lower 20 bits of the address in advanced mode.

2. Bits used for TPC output cannot be written.

3. The NDRA address is H'FFFA5 when the same output trigger is selected for TPC output groups 0 and 1 by settings in TPCR. When the output triggers are different, the NDRA address is H'FFFA7 for group 0 and H'FFFA5 for group 1. Similarly, the address of NDRB is H'FFFA4 when the same output trigger is selected for TPC output groups 2 and 3 by settings in TPCR. When the output triggers are different, the NDRB address is H'FFFA6 for group 2 and H'FFFA4 for group 3.

11.2 Register Descriptions

11.2.1 Port A Data Direction Register (PADDR)

PADDR is an 8-bit write-only register that selects input or output for each pin in port A.

Bit	7	6	5	4	3	2	1	0
	PA_7DDR	PA_6DDR	PA_5DDR	PA_4DDR	PA_3DDR	PA_2DDR	PA_1DDR	PA_0DDR
Initial value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W

Port A data direction 7 to 0
These bits select input or output for port A pins

Port A is multiplexed with pins TP_7 to TP_0. Bits corresponding to pins used for TPC output must be set to 1. For further information about PADDR, see section 8.11, Port A.

11.2.2 Port A Data Register (PADR)

PADR is an 8-bit readable/writable register that stores TPC output data for groups 0 and 1, when these TPC output groups are used.

Bit	7	6	5	4	3	2	1	0
	PA_7	PA_6	PA_5	PA_4	PA_3	PA_2	PA_1	PA_0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/(W)*

Port A data 7 to 0
These bits store output data for TPC output groups 0 and 1

Note: * Bits selected for TPC output by NDERA settings become read-only bits.

For further information about PADR, see section 8.11, Port A.

11.2.3 Port B Data Direction Register (PBDDR)

PBDDR is an 8-bit write-only register that selects input or output for each pin in port B.

Bit	7	6	5	4	3	2	1	0
	PB_7DDR	PB_6DDR	PB_5DDR	PB_4DDR	PB_3DDR	PB_2DDR	PB_1DDR	PB_0DDR
Initial value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W

Port B direction 7 to 0
These bits select input or output for port B pins

Port B is multiplexed with pins TP_{15} to TP_8. Bits corresponding to pins used for TPC output must be set to 1. For further information about PBDDR, see section 8.12, Port B.

11.2.4 Port B Data Register (PBDR)

PBDR is an 8-bit readable/writable register that stores TPC output data for groups 2 and 3, when these TPC output groups are used.

Bit	7	6	5	4	3	2	1	0
	PB_7	PB_6	PB_5	PB_4	PB_3	PB_2	PB_1	PB_0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/(W)*

Port B data 7 to 0
These bits store output data for TPC output groups 2 and 3

Note: * Bits selected for TPC output by NDERB settings become read-only bits.

For further information about PBDR, see section 8.12, Port B.

11.2.5 Next Data Register A (NDRA)

NDRA is an 8-bit readable/writable register that stores the next output data for TPC output groups 1 and 0 (pins TP_7 to TP_0). During TPC output, when an 16-bit timer compare match event specified in TPCR occurs, NDRA contents are transferred to the corresponding bits in PADR. The address of NDRA differs depending on whether TPC output groups 0 and 1 have the same output trigger or different output triggers.

NDRA is initialized to H'00 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Same Trigger for TPC Output Groups 0 and 1: If TPC output groups 0 and 1 are triggered by the same compare match event, the NDRA address is H'FFFA5. The upper 4 bits belong to group 1 and the lower 4 bits to group 0. Address H'FFFA7 consists entirely of reserved bits that cannot be modified and always read 1.

Address H'FFFA5

Bit	7	6	5	4	3	2	1	0
	NDR7	NDR6	NDR5	NDR4	NDR3	NDR2	NDR1	NDR0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Next data 7 to 4
These bits store the next output data for TPC output group 1

Next data 3 to 0
These bits store the next output data for TPC output group 0

Address H'FFFA7

Bit	7	6	5	4	3	2	1	0
	—	—	—	—	—	—	—	—
Initial value	1	1	1	1	1	1	1	1
Read/Write	—	—	—	—	—	—	—	—

Reserved bits

Different Triggers for TPC Output Groups 0 and 1: If TPC output groups 0 and 1 are triggered by different compare match events, the address of the upper 4 bits of NDRA (group 1) is H'FFFA5 and the address of the lower 4 bits (group 0) is H'FFFA7. Bits 3 to 0 of address H'FFFA5 and bits 7 to 4 of address H'FFFA7 are reserved bits that cannot be modified and always read 1.

Address H'FFFA5

Bit	7	6	5	4	3	2	1	0
	NDR7	NDR6	NDR5	NDR4	—	—	—	—
Initial value	0	0	0	0	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	—	—	—	—

Next data 7 to 4
These bits store the next output data for TPC output group 1

Reserved bits

Address H'FFFA7

Bit	7	6	5	4	3	2	1	0
	—	—	—	—	NDR3	NDR2	NDR1	NDR0
Initial value	1	1	1	1	0	0	0	0
Read/Write	—	—	—	—	R/W	R/W	R/W	R/W

Reserved bits

Next data 3 to 0
These bits store the next output data for TPC output group 0

11.2.6 Next Data Register B (NDRB)

NDRB is an 8-bit readable/writable register that stores the next output data for TPC output groups 3 and 2 (pins TP_{15} to TP_8). During TPC output, when an 16-bit timer compare match event specified in TPCR occurs, NDRB contents are transferred to the corresponding bits in PBDR. The address of NDRB differs depending on whether TPC output groups 2 and 3 have the same output trigger or different output triggers.

NDRB is initialized to H'00 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Same Trigger for TPC Output Groups 2 and 3: If TPC output groups 2 and 3 are triggered by the same compare match event, the NDRB address is H'FFFA4. The upper 4 bits belong to group 3 and the lower 4 bits to group 2. Address H'FFFA6 consists entirely of reserved bits that cannot be modified and always read 1.

Address H'FFFA4

Bit	7	6	5	4	3	2	1	0
	NDR15	NDR14	NDR13	NDR12	NDR11	NDR10	NDR9	NDR8
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Next data 15 to 12
These bits store the next output data for TPC output group 3

Next data 11 to 8
These bits store the next output data for TPC output group 2

Address H'FFFA6

Bit	7	6	5	4	3	2	1	0
	—	—	—	—	—	—	—	—
Initial value	1	1	1	1	1	1	1	1
Read/Write	—	—	—	—	—	—	—	—

Reserved bits

Different Triggers for TPC Output Groups 2 and 3: If TPC output groups 2 and 3 are triggered by different compare match events, the address of the upper 4 bits of NDRB (group 3) is H'FFFA4 and the address of the lower 4 bits (group 2) is H'FFFA6. Bits 3 to 0 of address H'FFFA4 and bits 7 to 4 of address H'FFFA6 are reserved bits that cannot be modified and always read 1.

Address H'FFFA4

Bit	7	6	5	4	3	2	1	0
	NDR15	NDR14	NDR13	NDR12	—	—	—	—
Initial value	0	0	0	0	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	—	—	—	—

Next data 15 to 12
These bits store the next output data for TPC output group 3

Reserved bits

Address H'FFFA6

Bit	7	6	5	4	3	2	1	0
	—	—	—	—	NDR11	NDR10	NDR9	NDR8
Initial value	1	1	1	1	0	0	0	0
Read/Write	—	—	—	—	R/W	R/W	R/W	R/W

Reserved bits

Next data 11 to 8
These bits store the next output data for TPC output group 2

11.2.7 Next Data Enable Register A (NDERA)

NDERA is an 8-bit readable/writable register that enables or disables TPC output groups 1 and 0 (TP_7 to TP_0) on a bit-by-bit basis.

Bit	7	6	5	4	3	2	1	0
	NDER7	NDER6	NDER5	NDER4	NDER3	NDER2	NDER1	NDER0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Next data enable 7 to 0
These bits enable or disable TPC output groups 1 and 0

If a bit is enabled for TPC output by NDERA, then when the 16-bit timer compare match event selected in the TPC output control register (TPCR) occurs, the NDRA value is automatically transferred to the corresponding PADR bit, updating the output value. If TPC output is disabled, the bit value is not transferred from NDRA to PADR and the output value does not change.

NDERA is initialized to H'00 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bits 7 to 0—Next Data Enable 7 to 0 (NDER7 to NDER0): These bits enable or disable TPC output groups 1 and 0 (TP_7 to TP_0) on a bit-by-bit basis.

Bits 7 to 0 NDER7 to NDER0	Description	
0	TPC outputs TP_7 to TP_0 are disabled (NDR7 to NDR0 are not transferred to PA_7 to PA_0)	(Initial value)
1	TPC outputs TP_7 to TP_0 are enabled (NDR7 to NDR0 are transferred to PA_7 to PA_0)	

11.2.8 Next Data Enable Register B (NDERB)

NDERB is an 8-bit readable/writable register that enables or disables TPC output groups 3 and 2 (TP_{15} to TP_8) on a bit-by-bit basis.

Bit	7	6	5	4	3	2	1	0
	NDER15	NDER14	NDER13	NDER12	NDER11	NDER10	NDER9	NDER8
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Next data enable 15 to 8
These bits enable or disable TPC output groups 3 and 2

If a bit is enabled for TPC output by NDERB, then when the 16-bit timer compare match event selected in the TPC output control register (TPCR) occurs, the NDRB value is automatically transferred to the corresponding PBDR bit, updating the output value. If TPC output is disabled, the bit value is not transferred from NDRB to PBDR and the output value does not change.

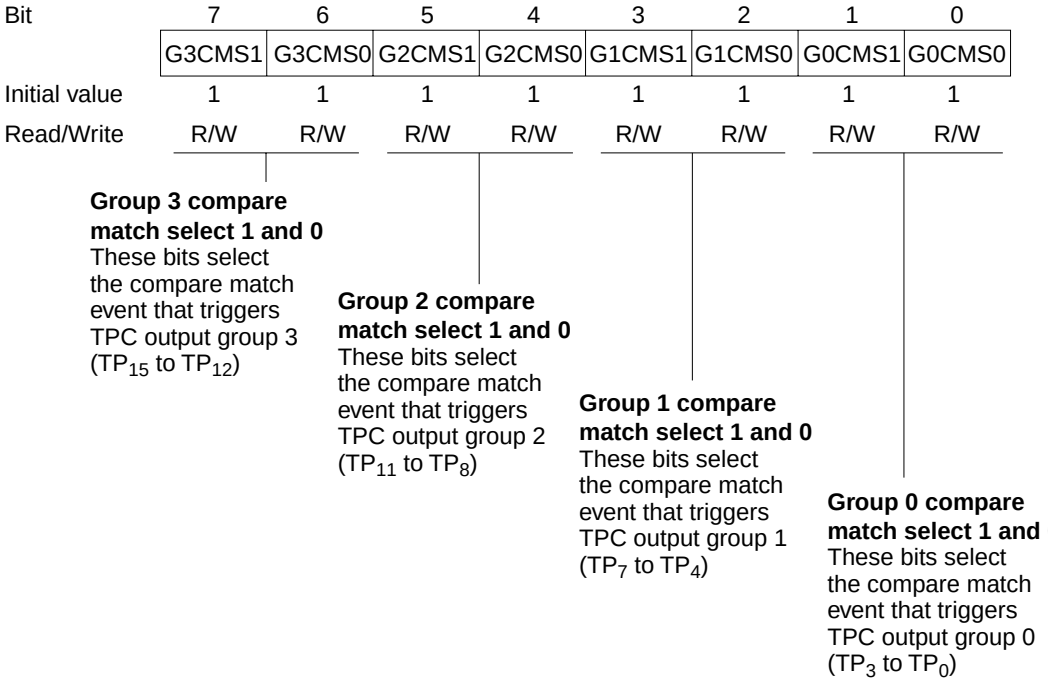
NDERB is initialized to H'00 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bits 7 to 0—Next Data Enable 15 to 8 (NDER15 to NDER8): These bits enable or disable TPC output groups 3 and 2 (TP_{15} to TP_8) on a bit-by-bit basis.

Bits 7 to 0 NDER15 to NDER8	Description	
0	TPC outputs TP_{15} to TP_8 are disabled (NDR15 to NDR8 are not transferred to PB_7 to PB_0)	(Initial value)
1	TPC outputs TP_{15} to TP_8 are enabled (NDR15 to NDR8 are transferred to PB_7 to PB_0)	

11.2.9 TPC Output Control Register (TPCR)

TPCR is an 8-bit readable/writable register that selects output trigger signals for TPC outputs on a group-by-group basis.



TPCR is initialized to H'FF by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bits 7 and 6—Group 3 Compare Match Select 1 and 0 (G3CMS1, G3CMS0): These bits select the compare match event that triggers TPC output group 3 (TP_{15} to TP_{12}).

Bit 7 G3CMS1	Bit 6 G3CMS0	Description
0	0	TPC output group 3 (TP_{15} to TP_{12}) is triggered by compare match in 16-bit timer channel 0
	1	TPC output group 3 (TP_{15} to TP_{12}) is triggered by compare match in 16-bit timer channel 1
1	0	TPC output group 3 (TP_{15} to TP_{12}) is triggered by compare match in 16-bit timer channel 2
	1	TPC output group 3 (TP_{15} to TP_{12}) is triggered by compare match in 16-bit timer channel 2 (Initial value)

Bits 5 and 4—Group 2 Compare Match Select 1 and 0 (G2CMS1, G2CMS0): These bits select the compare match event that triggers TPC output group 2 (TP_{11} to TP_{8}).

Bit 5 G2CMS1	Bit 4 G2CMS0	Description
0	0	TPC output group 2 (TP_{11} to TP_{8}) is triggered by compare match in 16-bit timer channel 0
	1	TPC output group 2 (TP_{11} to TP_{8}) is triggered by compare match in 16-bit timer channel 1
1	0	TPC output group 2 (TP_{11} to TP_{8}) is triggered by compare match in 16-bit timer channel 2
	1	TPC output group 2 (TP_{11} to TP_{8}) is triggered by compare match in 16-bit timer channel 2 (Initial value)

Bits 3 and 2—Group 1 Compare Match Select 1 and 0 (G1CMS1, G1CMS0): These bits select the compare match event that triggers TPC output group 1 (TP_7 to TP_4).

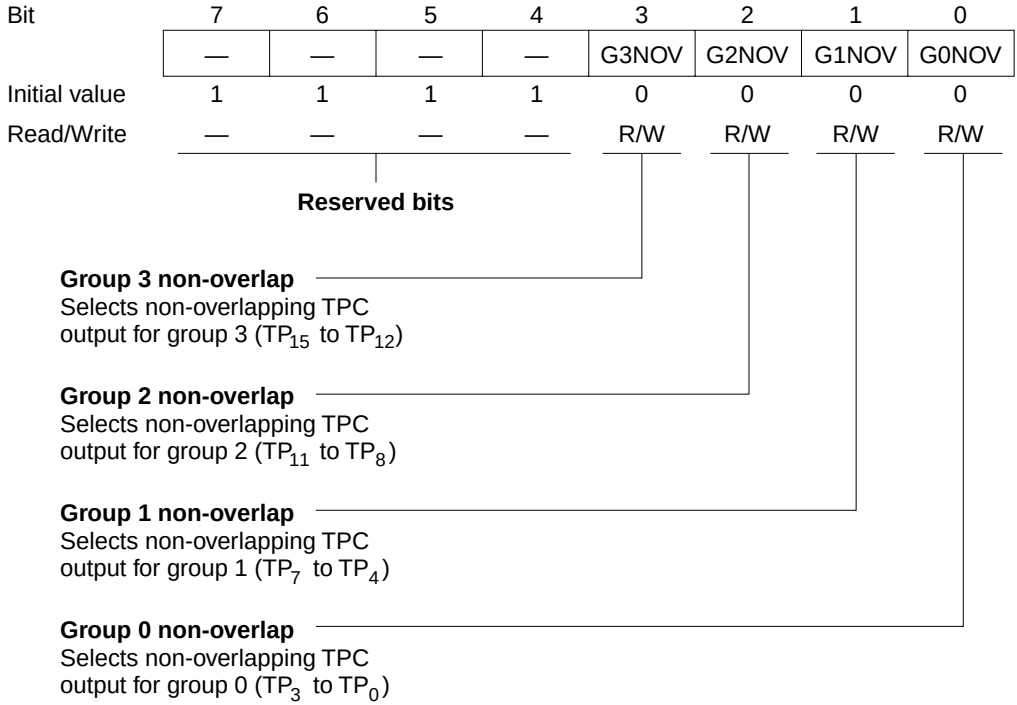
Bit 3 G1CMS1	Bit 2 G1CMS0	Description
0	0	TPC output group 1 (TP_7 to TP_4) is triggered by compare match in 16-bit timer channel 0
	1	TPC output group 1 (TP_7 to TP_4) is triggered by compare match in 16-bit timer channel 1
1	0	TPC output group 1 (TP_7 to TP_4) is triggered by compare match in 16-bit timer channel 2
	1	TPC output group 1 (TP_7 to TP_4) is triggered by compare match in 16-bit timer channel 2 (Initial value)

Bits 1 and 0—Group 0 Compare Match Select 1 and 0 (G0CMS1, G0CMS0): These bits select the compare match event that triggers TPC output group 0 (TP_3 to TP_0).

Bit 1 G0CMS1	Bit 0 G0CMS0	Description
0	0	TPC output group 0 (TP_3 to TP_0) is triggered by compare match in 16-bit timer channel 0
	1	TPC output group 0 (TP_3 to TP_0) is triggered by compare match in 16-bit timer channel 1
1	0	TPC output group 0 (TP_3 to TP_0) is triggered by compare match in 16-bit timer channel 2
	1	TPC output group 0 (TP_3 to TP_0) is triggered by compare match in 16-bit timer channel 2 (Initial value)

11.2.10 TPC Output Mode Register (TPMR)

TPMR is an 8-bit readable/writable register that selects normal or non-overlapping TPC output for each group.



The output trigger period of a non-overlapping TPC output waveform is set in general register B (GRB) in the 16-bit timer channel selected for output triggering. The non-overlap margin is set in general register A (GRA). The output values change at compare match A and B. For details see section 11.3.4, Non-Overlapping TPC Output.

TPMR is initialized to H'F0 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bits 7 to 4—Reserved: These bits cannot be modified and are always read as 1.

Bit 3—Group 3 Non-Overlap (G3NOV): Selects normal or non-overlapping TPC output for group 3 (TP_{15} to TP_{12}).

Bit 3 G3NOV	Description	
0	Normal TPC output in group 3 (output values change at compare match A in the selected 16-bit timer channel)	(Initial value)
1	Non-overlapping TPC output in group 3 (independent 1 and 0 output at compare match A and B in the selected 16-bit timer channel)	

Bit 2—Group 2 Non-Overlap (G2NOV): Selects normal or non-overlapping TPC output for group 2 (TP_{11} to TP_{8}).

Bit 2 G2NOV	Description	
0	Normal TPC output in group 2 (output values change at compare match A in the selected 16-bit timer channel)	(Initial value)
1	Non-overlapping TPC output in group 2 (independent 1 and 0 output at compare match A and B in the selected 16-bit timer channel)	

Bit 1—Group 1 Non-Overlap (G1NOV): Selects normal or non-overlapping TPC output for group 1 (TP_{7} to TP_{4}).

Bit 1 G1NOV	Description	
0	Normal TPC output in group 1 (output values change at compare match A in the selected 16-bit timer channel)	(Initial value)
1	Non-overlapping TPC output in group 1 (independent 1 and 0 output at compare match A and B in the selected 16-bit timer channel)	

Bit 0—Group 0 Non-Overlap (G0NOV): Selects normal or non-overlapping TPC output for group 0 (TP_{3} to TP_{0}).

Bit 0 G0NOV	Description	
0	Normal TPC output in group 0 (output values change at compare match A in the selected 16-bit timer channel)	(Initial value)
1	Non-overlapping TPC output in group 0 (independent 1 and 0 output at compare match A and B in the selected 16-bit timer channel)	

11.3 Operation

11.3.1 Overview

When corresponding bits in PADDR or PBDDR and NDERA or NDERB are set to 1, TPC output is enabled. The TPC output initially consists of the corresponding PADR or PBDR contents. When a compare-match event selected in TPCR occurs, the corresponding NDRA or NDRB bit contents are transferred to PADR or PBDR to update the output values.

Figure 11.2 illustrates the TPC output operation. Table 11.3 summarizes the TPC operating conditions.

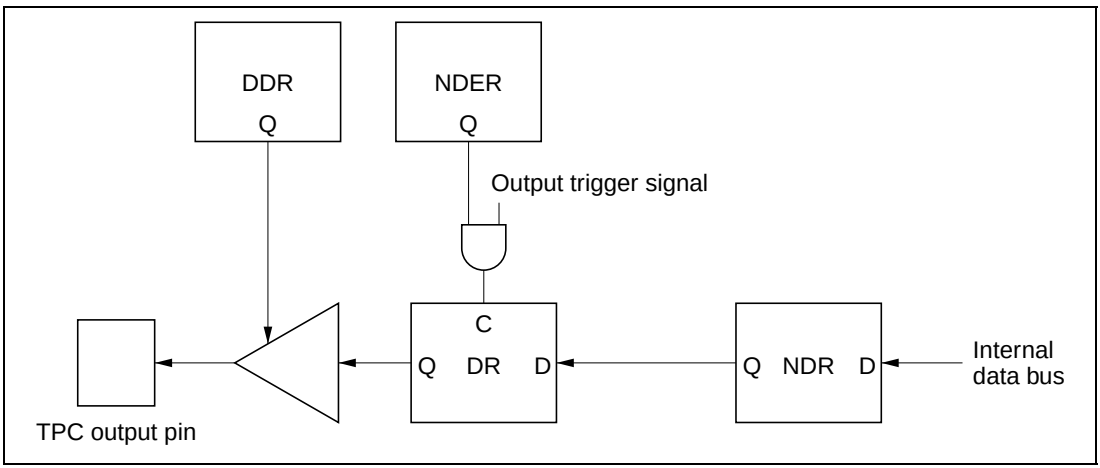


Figure 11.2 TPC Output Operation

Table 11.3 TPC Operating Conditions

NDER	DDR	Pin Function
0	0	Generic input port
	1	Generic output port
1	0	Generic input port (but the DR bit is a read-only bit, and when compare match occurs, the NDR bit value is transferred to the DR bit)
	1	TPC pulse output

Sequential output of up to 16-bit patterns is possible by writing new output data to NDRA and NDRB before the next compare match. For information on non-overlapping operation, see section 11.3.4, Non-Overlapping TPC Output.

11.3.2 Output Timing

If TPC output is enabled, NDRA/NDRB contents are transferred to PADR/PBDR and output when the selected compare match event occurs. Figure 11.3 shows the timing of these operations for the case of normal output in groups 2 and 3, triggered by compare match A.

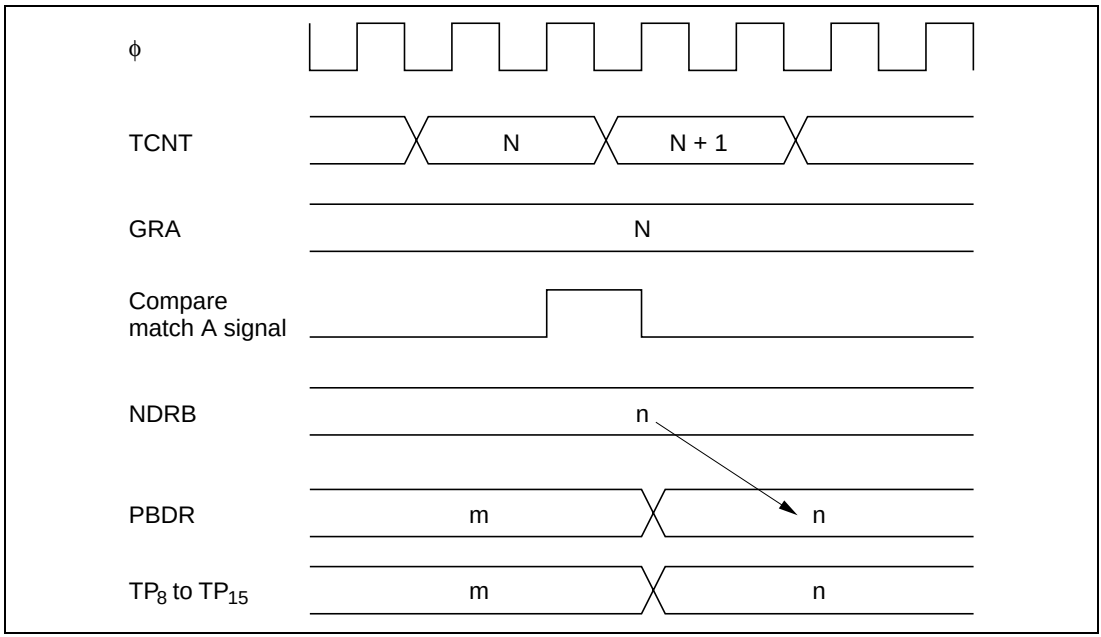


Figure 11.3 Timing of Transfer of Next Data Register Contents and Output (Example)

11.3.3 Normal TPC Output

Sample Setup Procedure for Normal TPC Output: Figure 11.4 shows a sample procedure for setting up normal TPC output.

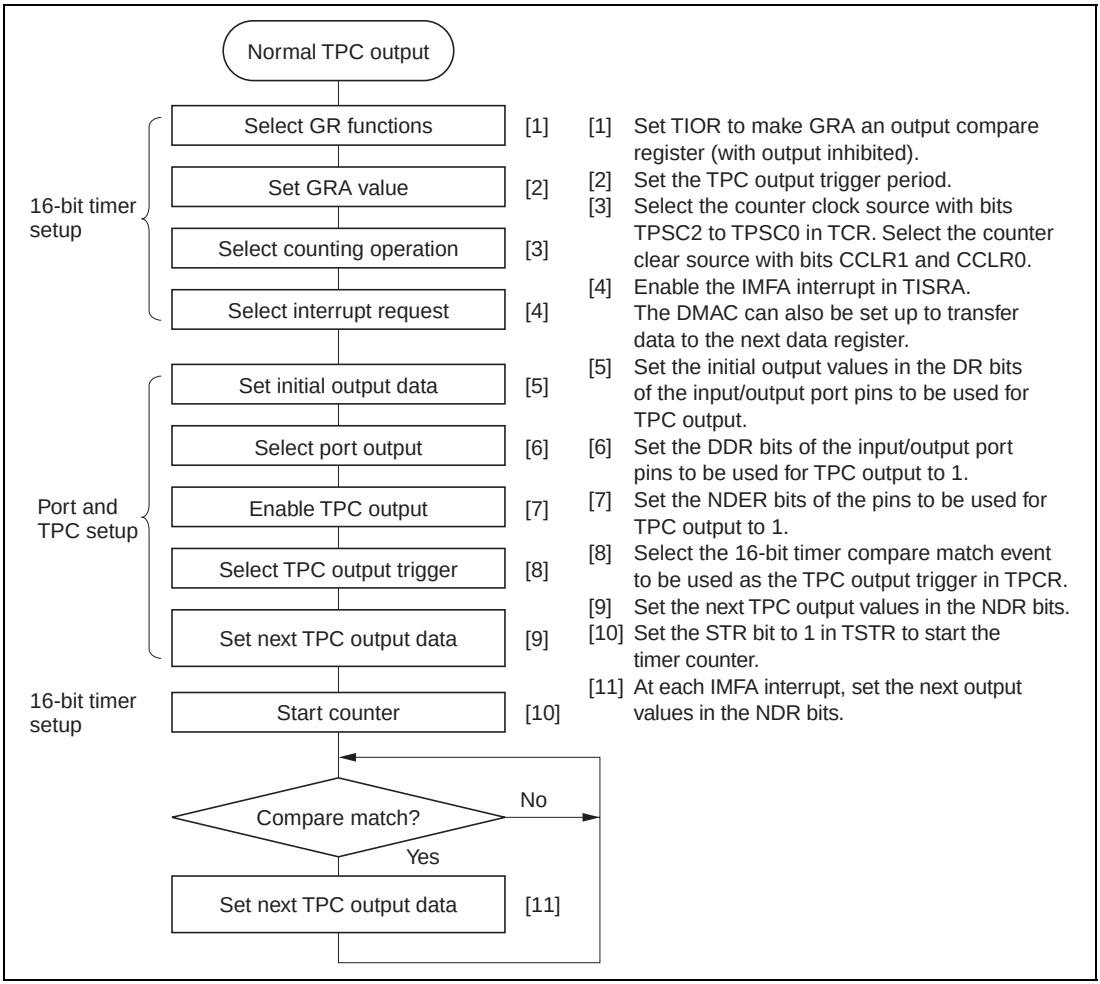
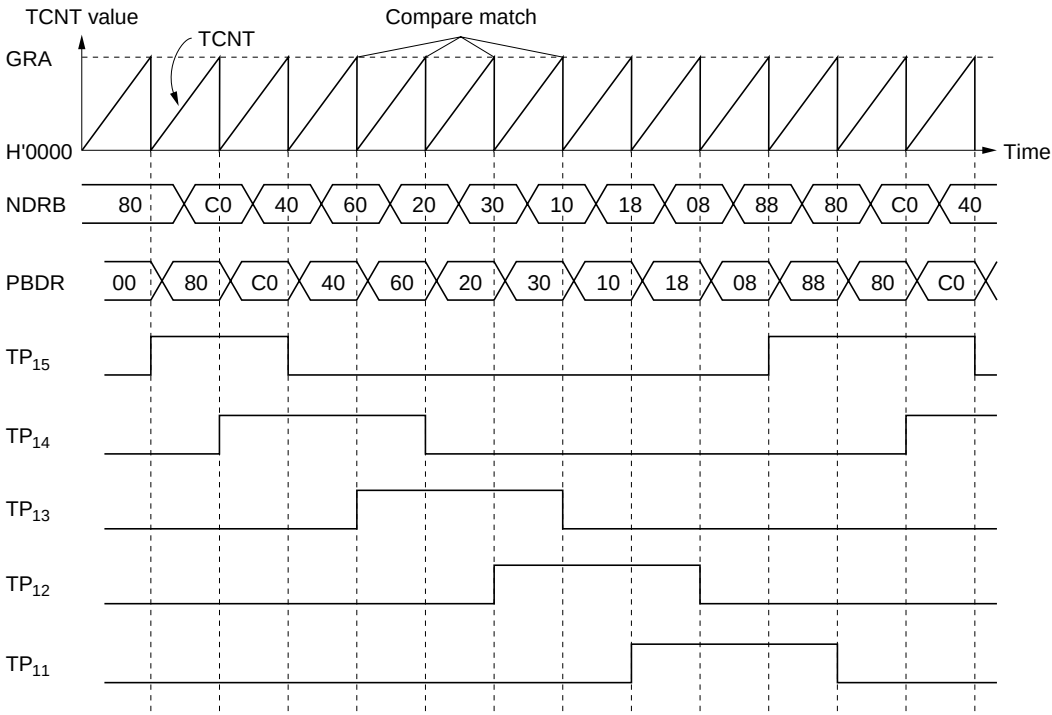


Figure 11.4 Setup Procedure for Normal TPC Output (Example)

Example of Normal TPC Output (Example of Five-Phase Pulse Output): Figure 11.5 shows an example in which the TPC is used for cyclic five-phase pulse output.



- The 16-bit timer channel to be used as the output trigger channel is set up so that GRA is an output compare register and the counter will be cleared by compare match A. The trigger period is set in GRA. The IMIEA bit is set to 1 in TISRA to enable the compare match A interrupt.
- H'F8 is written in PBDDR and NDERB, and bits G3CMS1, G3CMS0, G2CMS1, and G2CMS0 are set in TPCR to select compare match in the 16-bit timer channel set up in step 1 as the output trigger. Output data H'80 is written in NDRB.
- The timer counter in this 16-bit timer channel is started. When compare match A occurs, the NDRB contents are transferred to PBDR and output. The compare match/input capture A (IMFA) interrupt service routine writes the next output data (H'C0) in NDRB.
- Five-phase overlapping pulse output (one or two phases active at a time) can be obtained by writing H'40, H'60, H'20, H'30, H'10, H'18, H'08, H'88… at successive IMFA interrupts. If the DMAC is set for activation by this interrupt, pulse output can be obtained without loading the CPU.

Figure 11.5 Normal TPC Output Example (Five-Phase Pulse Output)

11.3.4 Non-Overlapping TPC Output

Sample Setup Procedure for Non-Overlapping TPC Output: Figure 11.6 shows a sample procedure for setting up non-overlapping TPC output.

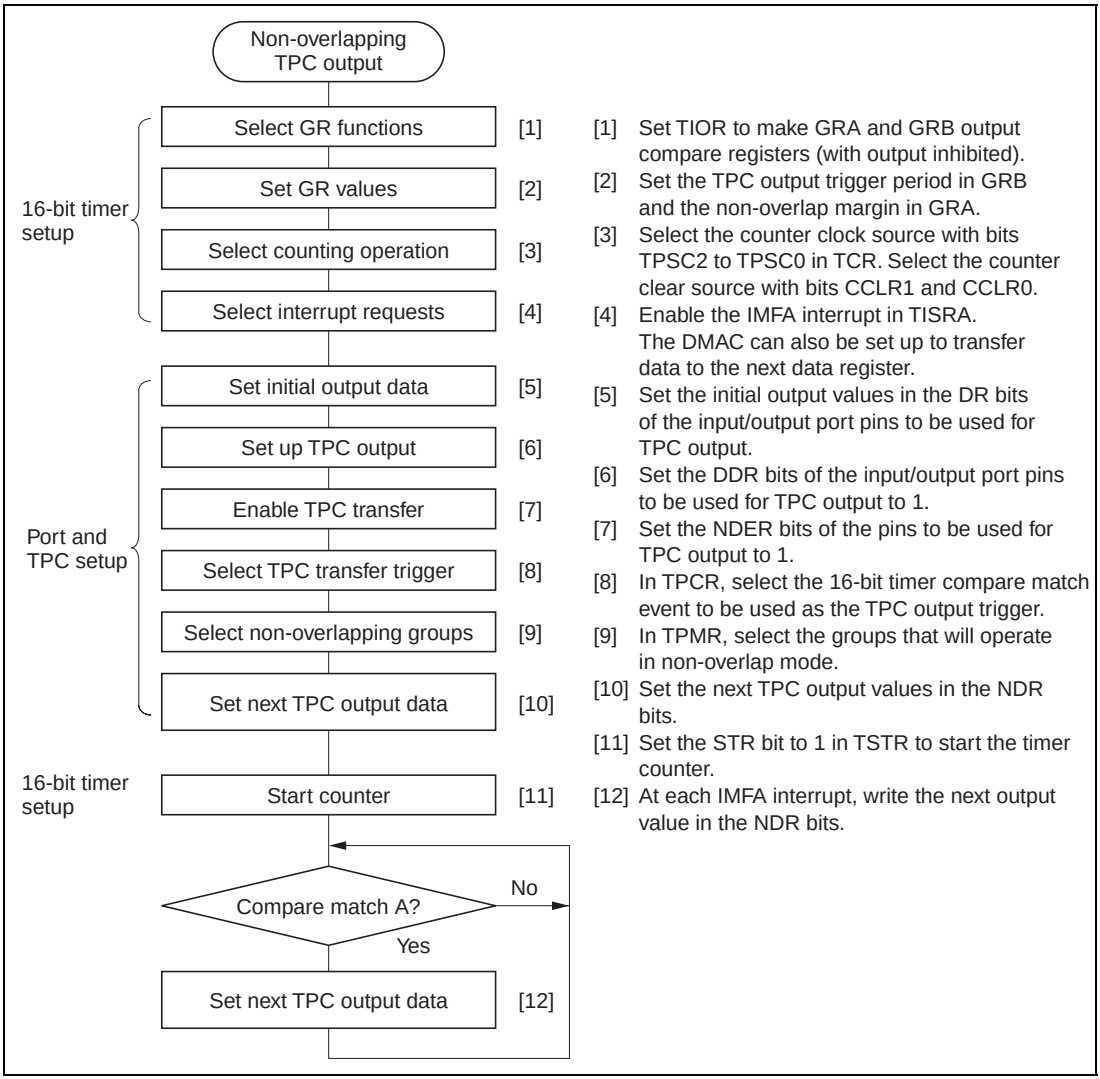
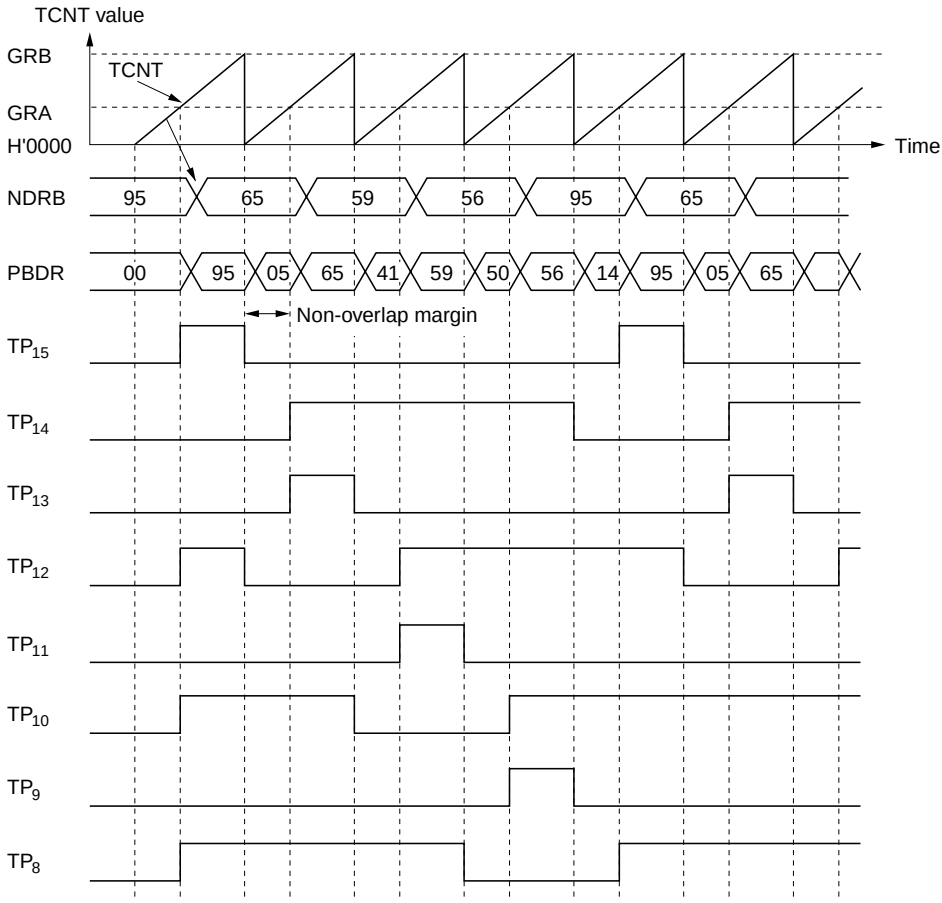


Figure 11.6 Setup Procedure for Non-Overlapping TPC Output (Example)

Example of Non-Overlapping TPC Output (Example of Four-Phase Complementary Non-Overlapping Output): Figure 11.7 shows an example of the use of TPC output for four-phase complementary non-overlapping pulse output.



- The 16-bit timer channel to be used as the output trigger channel is set up so that GRA and GRB are output compare registers and the counter will be cleared by compare match B. The TPC output trigger period is set in GRB. The non-overlap margin is set in GRA. The IMIEA bit is set to 1 in TISRA to enable IMFA interrupts.
- H'FF is written in PBDDR and NDERB, and bits G3CMS1, G3CMS0, G2CMS1, and G2CMS0 are set in TPCR to select compare match in the 16-bit timer channel set up in step 1 as the output trigger. Bits G3NOV and G2NOV are set to 1 in TPMR to select non-overlapping output. Output data H'95 is written in NDRB.
- The timer counter in this 16-bit timer channel is started. When compare match B occurs, outputs change from 1 to 0. When compare match A occurs, outputs change from 0 to 1 (the change from 0 to 1 is delayed by the value of GRA). The IMFA interrupt service routine writes the next output data (H'65) in NDRB.
- Four-phase complementary non-overlapping pulse output can be obtained by writing H'59, H'56, H'95… at successive IMFA interrupts. If the DMAC is set for activation by this interrupt, pulse output can be obtained without loading the CPU.

Figure 11.7 Non-Overlapping TPC Output Example (Four-Phase Complementary Non-Overlapping Pulse Output)

11.3.5 TPC Output Triggering by Input Capture

TPC output can be triggered by 16-bit timer input capture as well as by compare match. If GRA functions as an input capture register in the 16-bit timer channel selected in TPCR, TPC output will be triggered by the input capture signal. Figure 11.8 shows the timing.

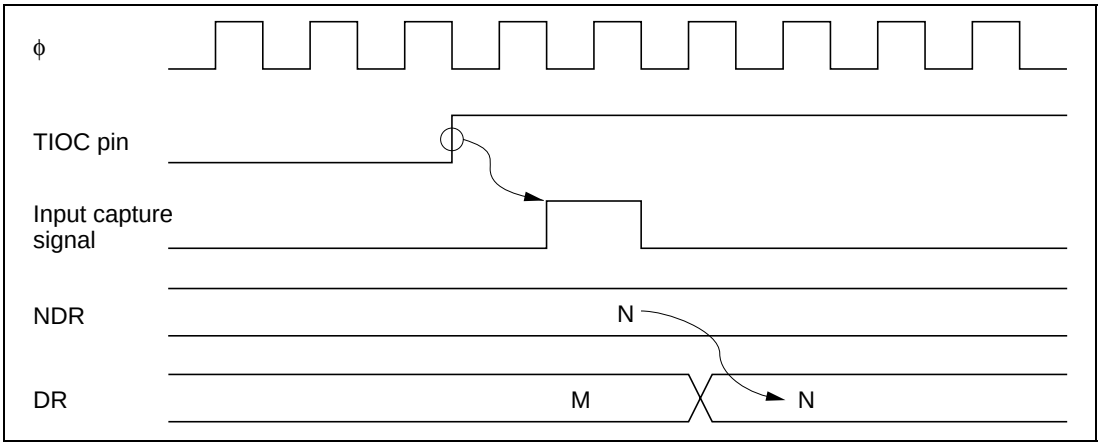


Figure 11.8 TPC Output Triggering by Input Capture (Example)

11.4 Usage Notes

11.4.1 Operation of TPC Output Pins

TP_0 to TP_{15} are multiplexed with 16-bit timer, DMAC, address bus, and other pin functions. When 16-bit timer, DMAC, or address output is enabled, the corresponding pins cannot be used for TPC output. The data transfer from NDR bits to DR bits takes place, however, regardless of the usage of the pin.

Pin functions should be changed only under conditions in which the output trigger event will not occur.

11.4.2 Note on Non-Overlapping Output

During non-overlapping operation, the transfer of NDR bit values to DR bits takes place as follows.

1. NDR bits are always transferred to DR bits at compare match A.
2. At compare match B, NDR bits are transferred only if their value is 0. Bits are not transferred if their value is 1.

Figure 11.9 illustrates the non-overlapping TPC output operation.

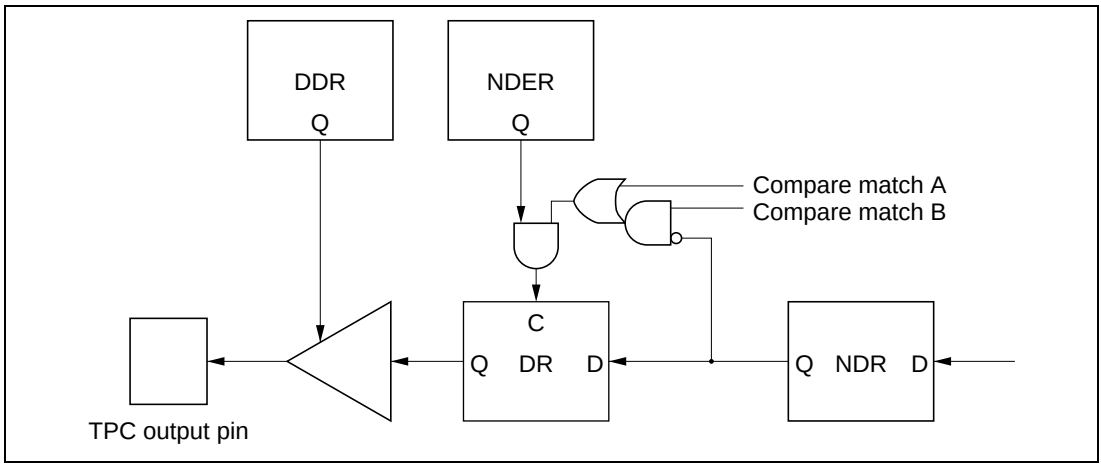


Figure 11.9 Non-Overlapping TPC Output

Therefore, 0 data can be transferred ahead of 1 data by making compare match B occur before compare match A. NDR contents should not be altered during the interval from compare match B to compare match A (the non-overlap margin).

This can be accomplished by having the IMFA interrupt service routine write the next data in NDR, or by having the IMFA interrupt activate the DMAC. The next data must be written before the next compare match B occurs.

Figure 11.10 shows the timing relationships.

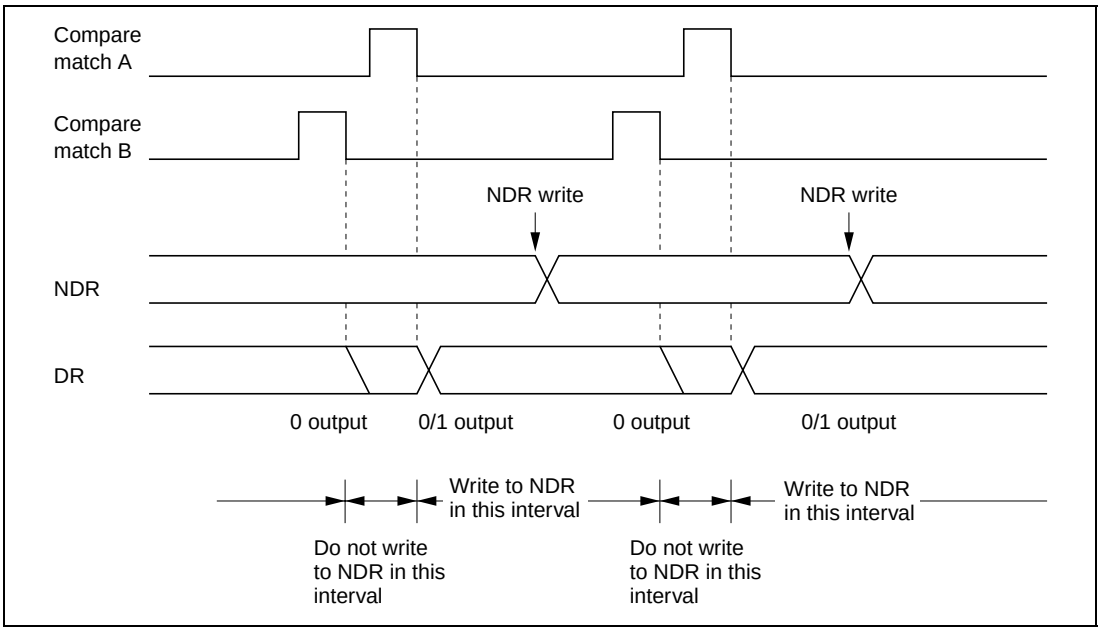


Figure 11.10 Non-Overlapping Operation and NDR Write Timing

Section 12 Watchdog Timer

12.1 Overview

The H8/3069R has an on-chip watchdog timer (WDT). The WDT has two selectable functions: it can operate as a watchdog timer to supervise system operation, or it can operate as an interval timer. As a watchdog timer, it generates a reset signal for the H8/3069R chip if a system crash allows the timer counter (TCNT) to overflow before being rewritten. In interval timer operation, an interval timer interrupt is requested at each TCNT overflow.

12.1.1 Features

WDT features are listed below.

- Selection of eight counter clock sources
  ϕ/2, ϕ /32, ϕ /64, ϕ /128, ϕ /256, ϕ /512, ϕ /2048, or ϕ /4096
- Interval timer option
- Timer counter overflow generates a reset signal or interrupt.
  The reset signal is generated in watchdog timer operation. An interval timer interrupt is generated in interval timer operation.
- Watchdog timer reset signal resets the entire H8/3069R internally.
  The reset signal generated by timer counter overflow during watchdog timer operation resets the entire H8/3069R internally.

12.1.2 Block Diagram

Figure 12.1 shows a block diagram of the WDT.

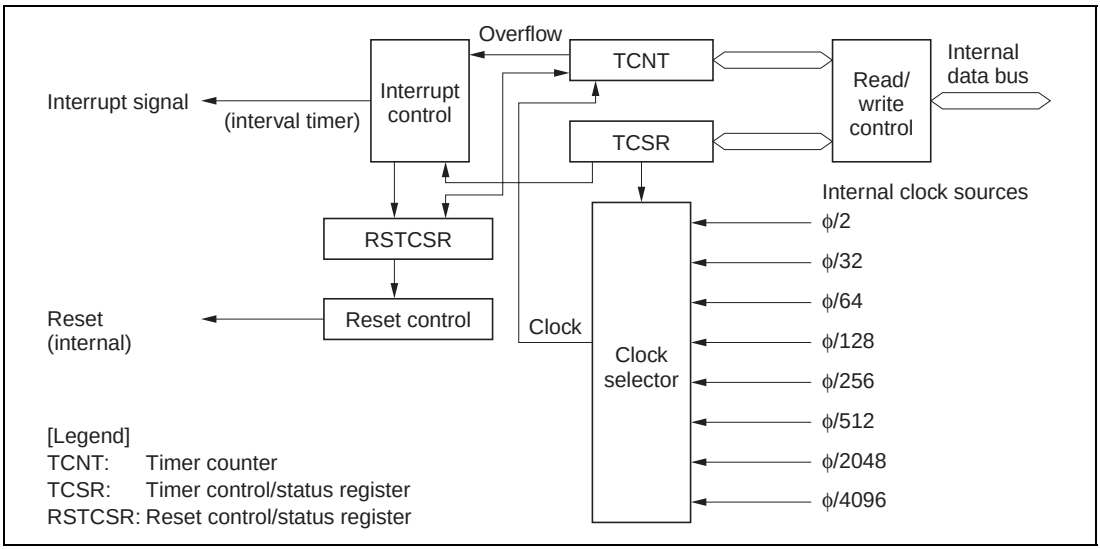


Figure 12.1 WDT Block Diagram

12.1.3 Register Configuration

Table 12.1 summarizes the WDT registers.

Table 12.1 WDT Registers

Address*[1]					
Write*[2]	**Read**	**Name**	**Abbreviation**	**R/W**	**Initial Value**
H'FFF8C	H'FFF8C	Timer control/status register	TCSR	R/(W)*[3]	H'18
	H'FFF8D	Timer counter	TCNT	R/W	H'00
H'FFF8E	H'FFF8F	Reset control/status register	RSTCSR	R/(W)*[3]	H'3F

Notes: 1. Lower 20 bits of the address in advanced mode.
2. Write word data starting at this address.
3. Only 0 can be written in bit 7, to clear the flag.

12.2 Register Descriptions

12.2.1 Timer Counter (TCNT)

TCNT is an 8-bit readable and writable up-counter.

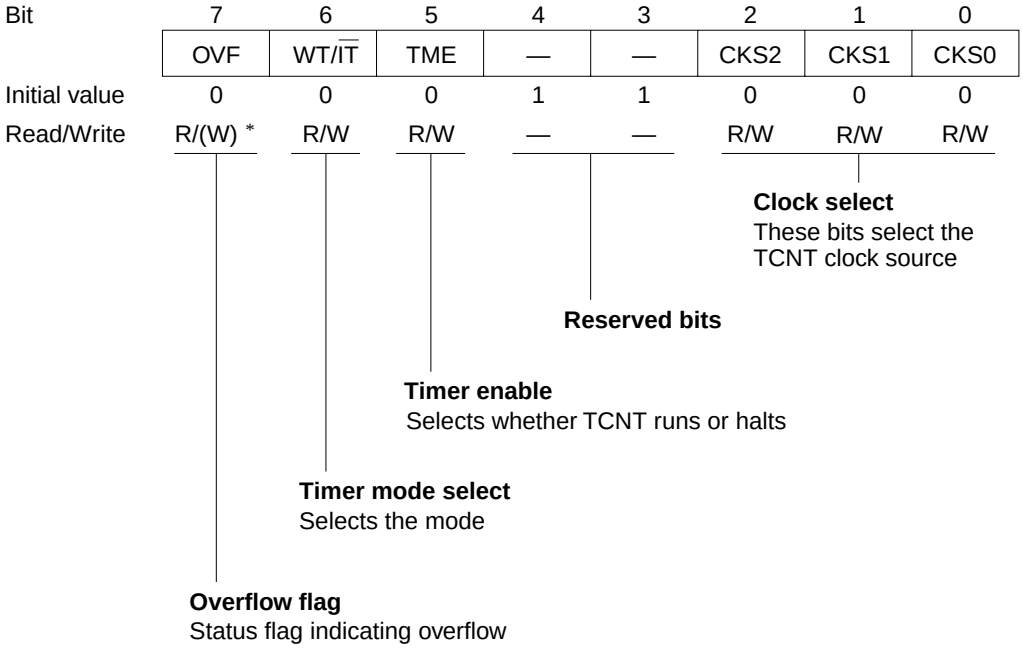
Bit	7	6	5	4	3	2	1	0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Note: TCNT is write-protected by a password. For details see section 12.2.4, Notes on Register Access.

When the TME bit is set to 1 in TCSR, TCNT starts counting pulses generated from an internal clock source selected by bits CKS2 to CKS0 in TCSR. When the count overflows (changes from H'FF to H'00), the OVF bit is set to 1 in TCSR. TCNT is initialized to H'00 by a reset and when the TME bit is cleared to 0.

12.2.2 Timer Control/Status Register (TCSR)

TCSR is an 8-bit readable and writable register. Its functions include selecting the timer mode and clock source.



Notes: TCSR is write-protected by a password. For details see section 12.2.4, Notes on Register Access.
* Only 0 can be written, to clear the flag.

Bits 7 to 5 are initialized to 0 by a reset and in standby mode. Bits 2 to 0 are initialized to 0 by a reset. In software standby mode bits 2 to 0 are not initialized, but retain their previous values.

Bit 7—Overflow Flag (OVF): This status flag indicates that the timer counter has overflowed from H'FF to H'00.

Bit 7 OVF	Description	
0	[Clearing condition] Cleared by reading OVF when OVF = 1, then writing 0 in OVF	(Initial value)
1	[Setting condition] Set when TCNT changes from H'FF to H'00	

Bit 6—Timer Mode Select (WT/$\overline{IT}$): Selects whether to use the WDT as a watchdog timer or interval timer. If used as an interval timer, the WDT generates an interval timer interrupt request when TCNT overflows. If used as a watchdog timer, the WDT generates a reset signal when TCNT overflows.

Bit 6 WT/$\overline{IT}$	Description	
0	Interval timer: requests interval timer interrupts	(Initial value)
1	Watchdog timer: generates a reset signal	

Bit 5—Timer Enable (TME): Selects whether TCNT runs or is halted. When WT/$\overline{IT}$ = 1, clear the software standby bit (SSBY) to 0 in SYSCR before setting TME. When setting SSBY to 1, TME should be cleared to 0.

Bit 5 TME	Description	
0	TCNT is initialized to H'00 and halted	(Initial value)
1	TCNT is counting	

Bits 4 and 3—Reserved: These bits cannot be modified and are always read as 1.

Bits 2 to 0—Clock Select 2 to 0 (CKS2/1/0): These bits select one of eight internal clock sources, obtained by prescaling the system clock (ϕ), for input to TCNT.

Bit 2 CKS2	Bit 1 CKS1	Bit 0 CKS0	Description
0	0	0	ϕ/2 (Initial value)
		1	ϕ /32
	1	0	ϕ /64
		1	ϕ /128
1	0	0	ϕ /256
		1	ϕ /512
	1	0	ϕ /2048
		1	ϕ /4096

12.2.3 Reset Control/Status Register (RSTCSR)

RSTCSR is an 8-bit readable and writable register that indicates when a reset signal has been generated by watchdog timer overflow, and controls external output of the reset signal.

Bit	7	6	5	4	3	2	1	0
	WRST	—	—	—	—	—	—	—
Initial value	0	0	1	1	1	1	1	1
Read/Write	R/(W)*	R/W	—	—	—	—	—	—

Watchdog timer reset
Indicates that a reset signal has been generated

Reserved bits

Notes: RSTCSR is write-protected by a password. For details see section 12.2.4, Notes on Register Access.
* Only 0 can be written in bit 7, to clear the flag.

Bits 7 and 6 are initialized by input of a reset signal at the $\overline{\text{RES}}$ pin. They are not initialized by reset signals generated by watchdog timer overflow.

Bit 7—Watchdog Timer Reset (WRST): During watchdog timer operation, this bit indicates that TCNT has overflowed and generated a reset signal. This reset signal resets the entire H8/3069R chip internally.

Bit 7 WRST	Description	
0	[Clearing condition] Reset signal at $\overline{\text{RES}}$ pin. Read WRST when WRST =1, then write 0 in WRST.	(Initial value)
1	[Setting condition] Set when TCNT overflow generates a reset signal during watchdog timer operation	

Bit 6—Reserved: The write value should always be 0.

Bits 5 to 0—Reserved: These bits are always read as 1. The write value should always be 1.

12.2.4 Notes on Register Access

The watchdog timer's TCNT, TCSR, and RSTCSR registers differ from other registers in being more difficult to write. The procedures for writing and reading these registers are given below.

Writing to TCNT and TCSR: These registers must be written by a word transfer instruction. They cannot be written by byte instructions. Figure 12.2 shows the format of data written to TCNT and TCSR. TCNT and TCSR both have the same write address. The write data must be contained in the lower byte of the written word. The upper byte must contain H'5A (password for TCNT) or H'A5 (password for TCSR). This transfers the write data from the lower byte to TCNT or TCSR.

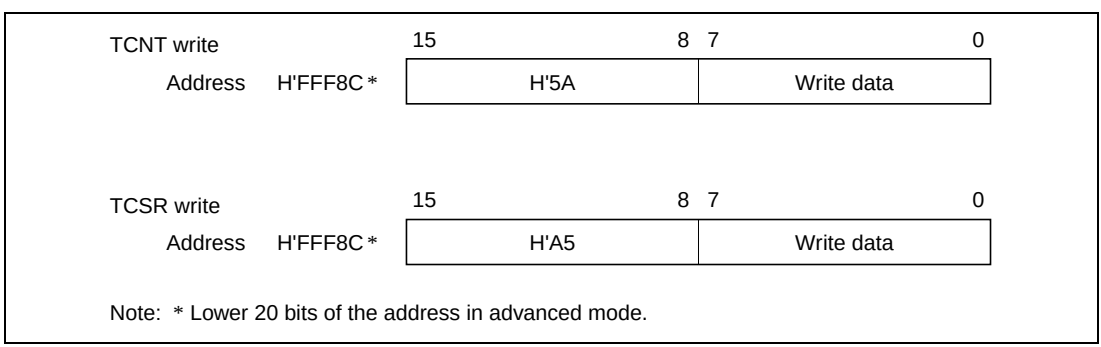


Figure 12.2 Format of Data Written to TCNT and TCSR

Writing to RSTCSR: RSTCSR must be written by a word transfer instruction. It cannot be written by byte transfer instructions. Figure 12.3 shows the format of data written to RSTCSR. To write 0 in the WRST bit, the write data must have H'A5 in the upper byte and H'00 in the lower byte. The data (H'00) in the lower byte is written to RSTCSR, clearing the WRST bit to 0.

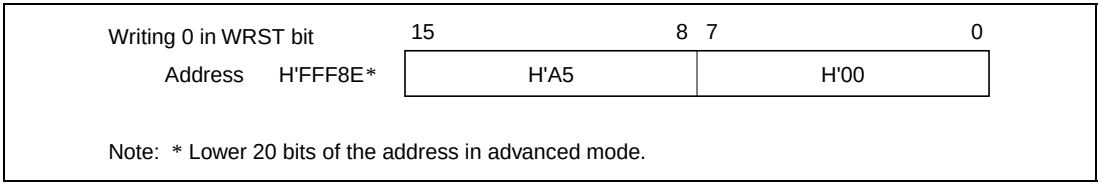


Figure 12.3 Format of Data Written to RSTCSR

Reading TCNT, TCSR, and RSTCSR: These registers are read like other registers. Reading TCNT, TCSR, and RSTCSR: These registers are read like other registers. Byte transfer instructions can be used. The read addresses are H'FFF8C for TCSR, H'FFF8D for TCNT, and H'FFF8F for RSTCSR, as listed in table 12.2.

Table 12.2 Read Addresses of TCNT, TCSR, and RSTCSR

Address*	Register
H'FFF8C	TCSR
H'FFF8D	TCNT
H'FFF8F	RSTCSR

Note: * Lower 20 bits of the address in advanced mode.

12.3 Operation

Operations when the WDT is used as a watchdog timer and as an interval timer are described below.

12.3.1 Watchdog Timer Operation

Figure 12.4 illustrates watchdog timer operation. To use the WDT as a watchdog timer, set the WT/$\overline{IT}$ and TME bits to 1 in TCSR. Software must prevent TCNT overflow by rewriting the TCNT value (normally by writing H'00) before overflow occurs. If TCNT fails to be rewritten and overflows due to a system crash etc., the H8/3069R is internally reset for a duration of 518 states.

A watchdog reset has the same vector as a reset generated by input at the $\overline{RES}$ pin. Software can distinguish a $\overline{RES}$ reset from a watchdog reset by checking the WRST bit in RSTCSR.

If a $\overline{RES}$ reset and a watchdog reset occur simultaneously, the $\overline{RES}$ reset takes priority.

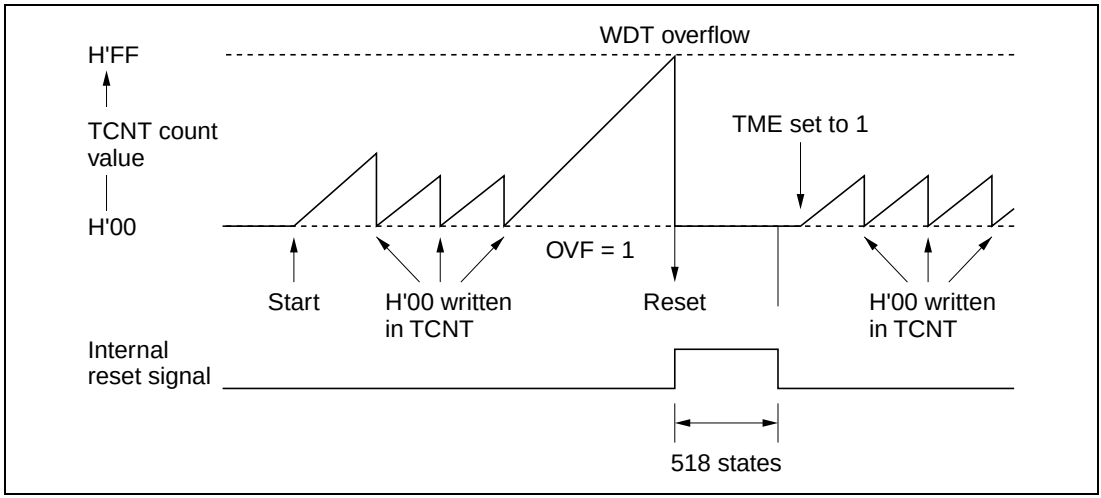


Figure 12.4 Operation in Watchdog Timer Mode

12.3.2 Interval Timer Operation

Figure 12.5 illustrates interval timer operation. To use the WDT as an interval timer, clear bit WT/$\overline{IT}$ to 0 and set bit TME to 1 in TCSR. An interval timer interrupt request is generated at each TCNT overflow. This function can be used to generate interval timer interrupts at regular intervals.

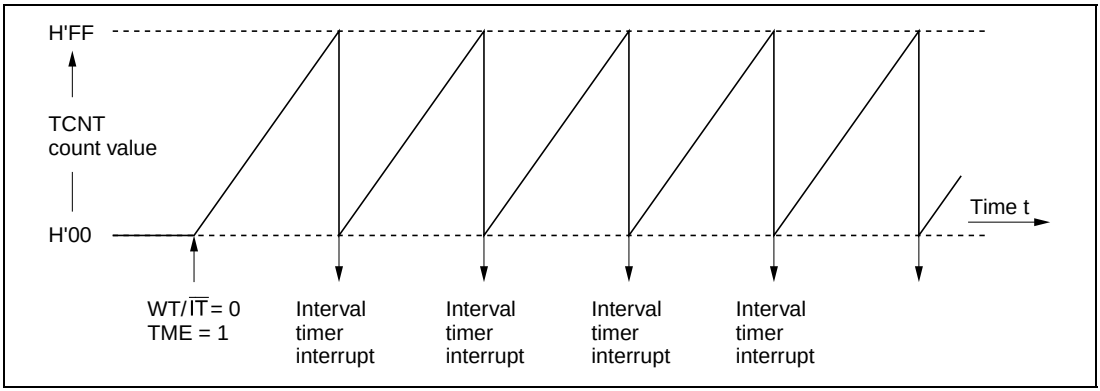


Figure 12.5 Interval Timer Operation

12.3.3 Timing of Setting of Overflow Flag (OVF)

Figure 12.6 shows the timing of setting of the OVF flag. The OVF flag is set to 1 when TCNT overflows. At the same time, a reset signal is generated in watchdog timer operation, or an interval timer interrupt is generated in interval timer operation.

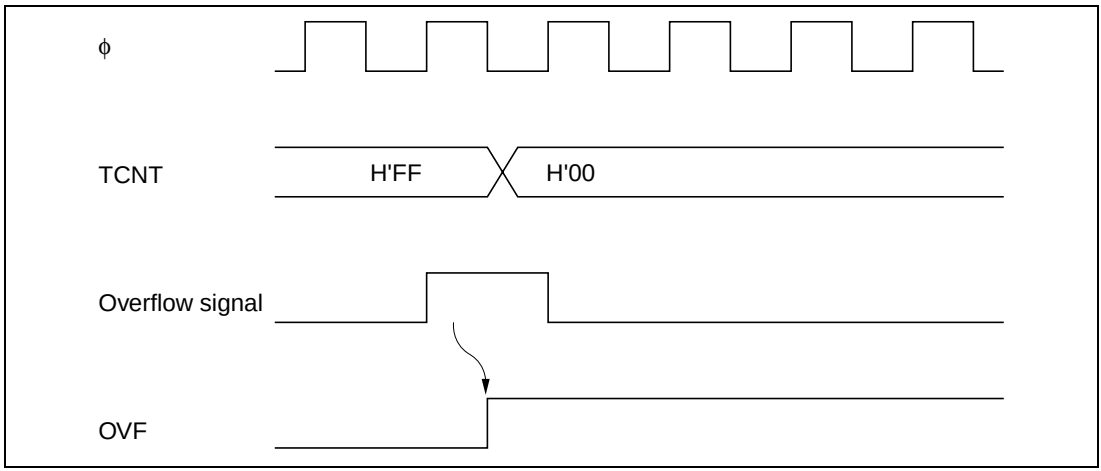


Figure 12.6 Timing of Setting of OVF

12.3.4 Timing of Setting of Watchdog Timer Reset Bit (WRST)

The WRST bit in RSTCSR is valid when bits WT/$\overline{IT}$ and TME are both set to 1 in TCSR.

Figure 12.7 shows the timing of setting of WRST and the internal reset timing. The WRST bit is set to 1 when TCNT overflows and OVF is set to 1. At the same time an internal reset signal is generated for the entire H8/3069R chip. This internal reset signal clears OVF to 0, but the WRST bit remains set to 1. The reset routine must therefore clear the WRST bit.

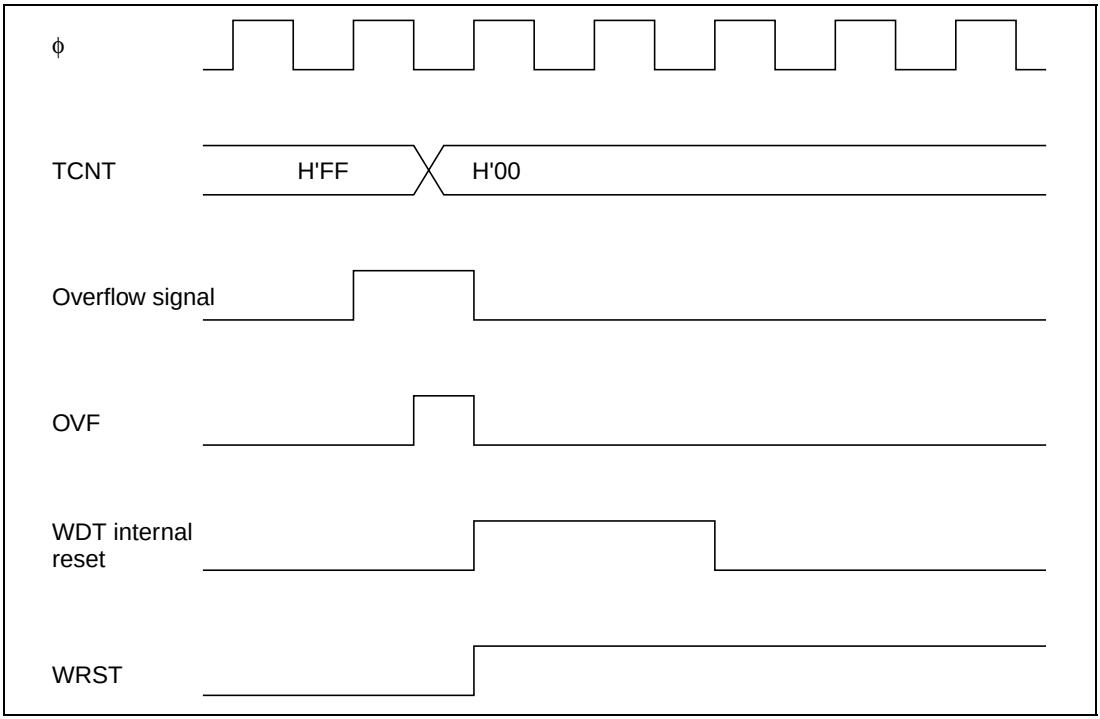


Figure 12.7 Timing of Setting of WRST Bit and Internal Reset

12.4 Interrupts

During interval timer operation, an overflow generates an interval timer interrupt (WOVI). The interval timer interrupt is requested whenever the OVF bit is set to 1 in TCSR.

12.5 Usage Notes

Contention between TCNT Write and Increment: If a timer counter clock pulse is generated during the T_3 state of a write cycle to TCNT, the write takes priority and the timer count is not incremented. See figure 12.8.

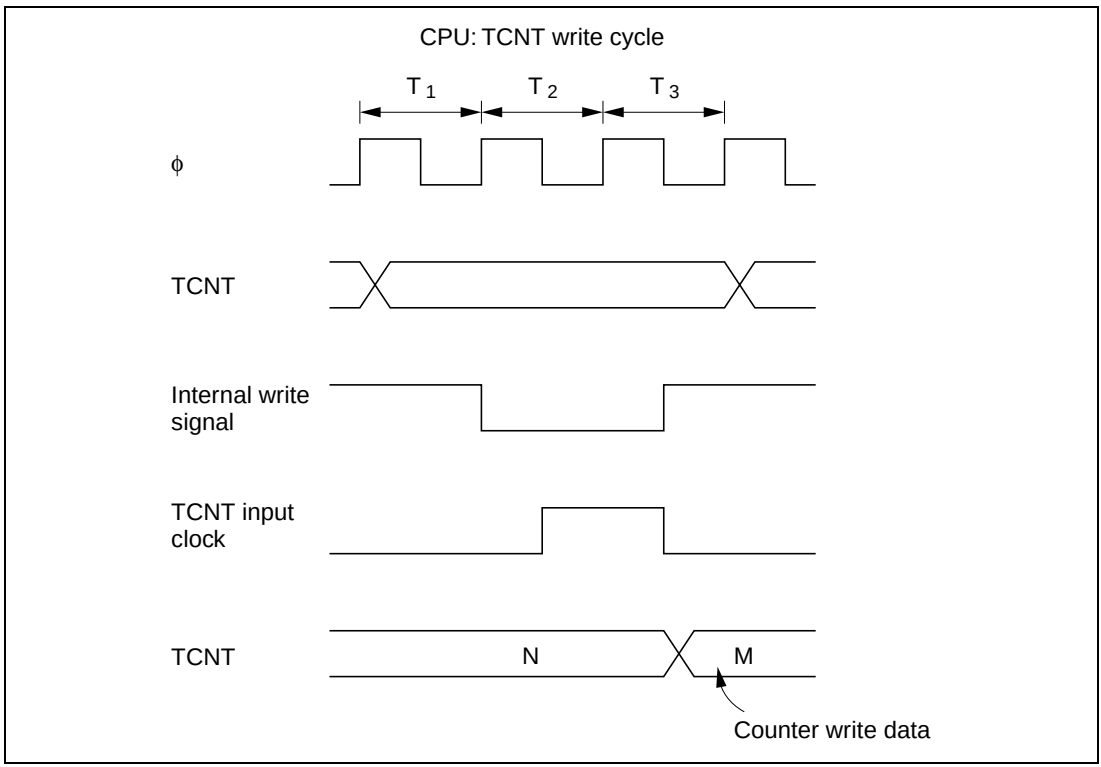


Figure 12.8 Contention between TCNT Write and Count up

Changing CKS2 to CKS0 Bit: Halt TCNT by clearing the TME bit to 0 in TCSR before changing the values of bits CKS2 to CKS0.

Section 13 Serial Communication Interface

13.1 Overview

The H8/3069R has a serial communication interface (SCI) with three independent channels. All three channels have identical functions. The SCI can communicate in both asynchronous and synchronous mode. It also has a multiprocessor communication function for serial communication among two or more processors.

When the SCI is not used, it can be halted to conserve power. Each SCI channel can be halted independently. For details, see section 20.6, Module Standby Function.

The SCI also has a smart card interface function conforming to the ISO/IEC 7816-3 (Identification Card) standard. This function supports serial communication with a smart card. Switching between the normal serial communication interface and the smart card interface is carried out by means of a register setting.

13.1.1 Features

SCI features are listed below.

- Selection of synchronous or asynchronous mode for serial communication

  Asynchronous mode

  Serial data communication is synchronized one channel at a time. The SCI can communicate with a universal asynchronous receiver/transmitter (UART), asynchronous communication interface adapter (ACIA), or other chip that employs standard asynchronous communication. It can also communicate with two or more other processors using the multiprocessor communication function. There are 12 selectable serial data transfer formats.

  — Data length: 7 or 8 bits
  — Stop bit length: 1 or 2 bits
  — Parity: even/odd/none
  — Multiprocessor bit: 1 or 0
  — Receive error detection: parity, overrun, and framing errors
  — Break detection: by reading the RxD level directly when a framing error occurs

  Synchronous mode

  Serial data communication is synchronized with a clock signal. The SCI can communicate with other chips having a synchronous communication function.

  There is a single serial data communication format.

  — Data length: 8 bits
  — Receive error detection: overrun errors

- Full-duplex communication

  The transmitting and receiving sections are independent, so the SCI can transmit and receive simultaneously. The transmitting and receiving sections are both double-buffered, so serial data can be transmitted and received continuously.
- The following settings can be made for the serial data to be transferred:
  - LSB-first or MSB-first transfer
  - Inversion of data logic level
- Built-in baud rate generator with selectable bit rates
- Selectable transmit/receive clock sources: internal clock from baud rate generator, or external clock from the SCK pin
- Four types of interrupts

  Transmit-data-empty, transmit-end, receive-data-full, and receive-error interrupts are requested independently. The transmit-data-empty and receive-data-full interrupts from SCI0 can activate the DMA controller (DMAC) to transfer data.

Features of the smart card interface are listed below.

- Asynchronous communication
  - Data length: 8 bits
  - Parity bits generated and checked
  - Error signal output in receive mode (parity error)
  - Error signal detect and automatic data retransmit in transmit mode
  - Supports both direct convention and inverse convention
- Built-in baud rate generator with selectable bit rates
- Three types of interrupts

  Transmit-data-empty, receive-data-full, and transmit/receive-error interrupts are requested independently. The transmit-data-empty and receive-data-full interrupts can activate the DMA controller (DMAC) to transfer data.

13.1.2 Block Diagram

Figure 13.1 shows a block diagram of the SCI.

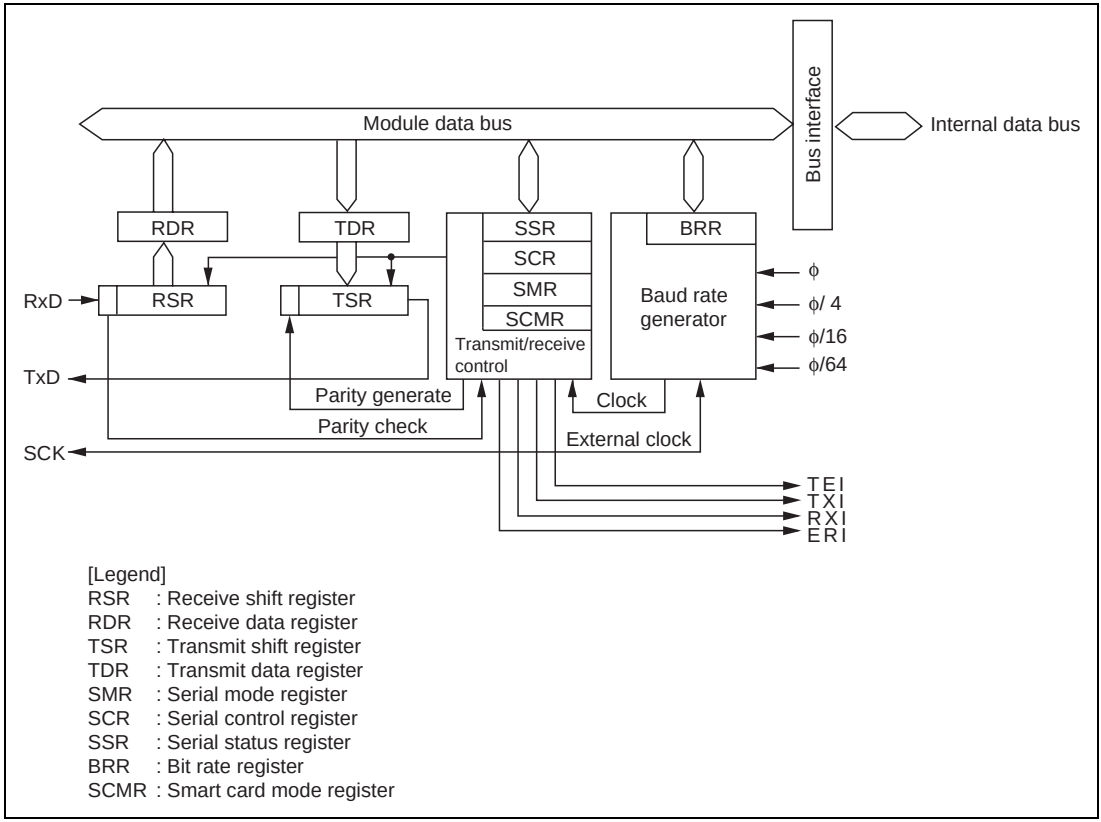


Figure 13.1 SCI Block Diagram

13.1.3 Input/Output Pins

The SCI has serial pins for each channel as listed in table 13.1.

Table 13.1 SCI Pins

Channel	Name	Abbreviation	I/O	Function
0	Serial clock pin	SCK_0	Input/output	SCI_0 clock input/output
	Receive data pin	RxD_0	Input	SCI_0 receive data input
	Transmit data pin	TxD_0	Output	SCI_0 transmit data output
1	Serial clock pin	SCK_1	Input/output	SCI_1 clock input/output
	Receive data pin	RxD_1	Input	SCI_1 receive data input
	Transmit data pin	TxD_1	Output	SCI_1 transmit data output
2	Serial clock pin	SCK_2	Input/output	SCI_2 clock input/output
	Receive data pin	RxD_2	Input	SCI_2 receive data input
	Transmit data pin	TxD_2	Output	SCI_2 transmit data output

13.1.4 Register Configuration

The SCI has internal registers as listed in table 13.2. These registers select asynchronous or synchronous mode, specify the data format and bit rate, control the transmitter and receiver sections, and specify switching between the serial communication interface and smart card interface.

Table 13.2 SCI Registers

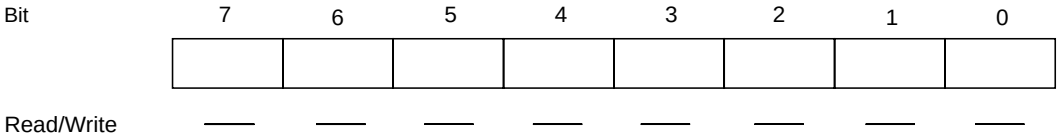
Channel	Address*[1]	Name	Abbreviation	R/W	Initial Value
0	H'FFFB0	Serial mode register	SMR	R/W	H'00
	H'FFFB1	Bit rate register	BRR	R/W	H'FF
	H'FFFB2	Serial control register	SCR	R/W	H'00
	H'FFFB3	Transmit data register	TDR	R/W	H'FF
	H'FFFB4	Serial status register	SSR	R/(W)*[2]	H'84
	H'FFFB5	Receive data register	RDR	R	H'00
	H'FFFB6	Smart card mode register	SCMR	R/W	H'F2
1	H'FFFB8	Serial mode register	SMR	R/W	H'00
	H'FFFB9	Bit rate register	BRR	R/W	H'FF
	H'FFFBA	Serial control register	SCR	R/W	H'00
	H'FFFBB	Transmit data register	TDR	R/W	H'FF
	H'FFFBC	Serial status register	SSR	R/(W)*[2]	H'84
	H'FFFBD	Receive data register	RDR	R	H'00
	H'FFFBE	Smart card mode register	SCMR	R/W	H'F2
2	H'FFFC0	Serial mode register	SMR	R/W	H'00
	H'FFFC1	Bit rate register	BRR	R/W	H'FF
	H'FFFC2	Serial control register	SCR	R/W	H'00
	H'FFFC3	Transmit data register	TDR	R/W	H'FF
	H'FFFC4	Serial status register	SSR	R/(W)*[2]	H'84
	H'FFFC5	Receive data register	RDR	R	H'00
	H'FFFC6	Smart card mode register	SCMR	R/W	H'F2

Notes: 1. Indicates the lower 20 bits of the address in advanced mode.
2. Only 0 can be written, to clear flags.

13.2 Register Descriptions

13.2.1 Receive Shift Register (RSR)

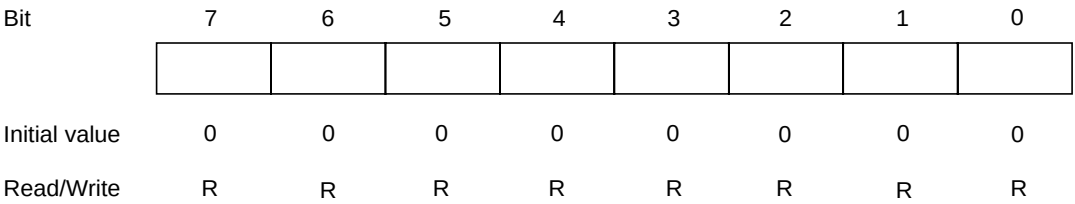
RSR is the register that receives serial data.



The SCI loads serial data input at the RxD pin into RSR in the order received, LSB (bit 0) first, thereby converting the data to parallel data. When one byte of data has been received, it is automatically transferred to RDR. The CPU cannot read or write RSR directly.

13.2.2 Receive Data Register (RDR)

RDR is the register that stores received serial data.

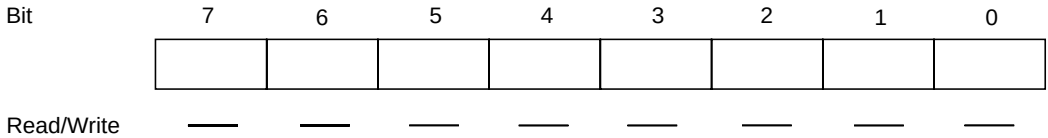


When the SCI has received one byte of serial data, it transfers the received data from RSR into RDR for storage, completing the receive operation. RSR is then ready to receive the next data. This double-buffering allows data to be received continuously.

RDR is a read-only register. Its contents cannot be modified by the CPU. RDR is initialized to H'00 by a reset and in standby mode.

13.2.3 Transmit Shift Register (TSR)

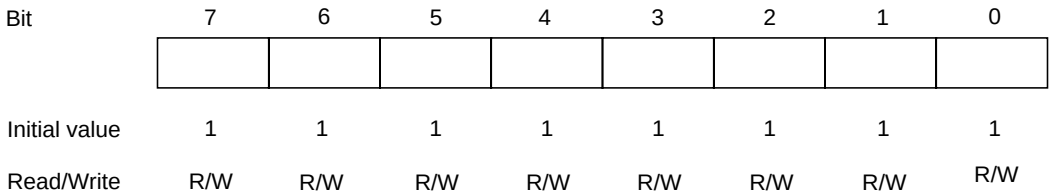
TSR is the register that transmits serial data.



The SCI loads transmit data from TDR to TSR, then transmits the data serially from the TxD pin, LSB (bit 0) first. After transmitting one data byte, the SCI automatically loads the next transmit data from TDR into TSR and starts transmitting it. If the TDRE flag is set to 1 in SSR, however, the SCI does not load the TDR contents into TSR. The CPU cannot read or write RSR directly.

13.2.4 Transmit Data Register (TDR)

TDR is an 8-bit register that stores data for serial transmission.

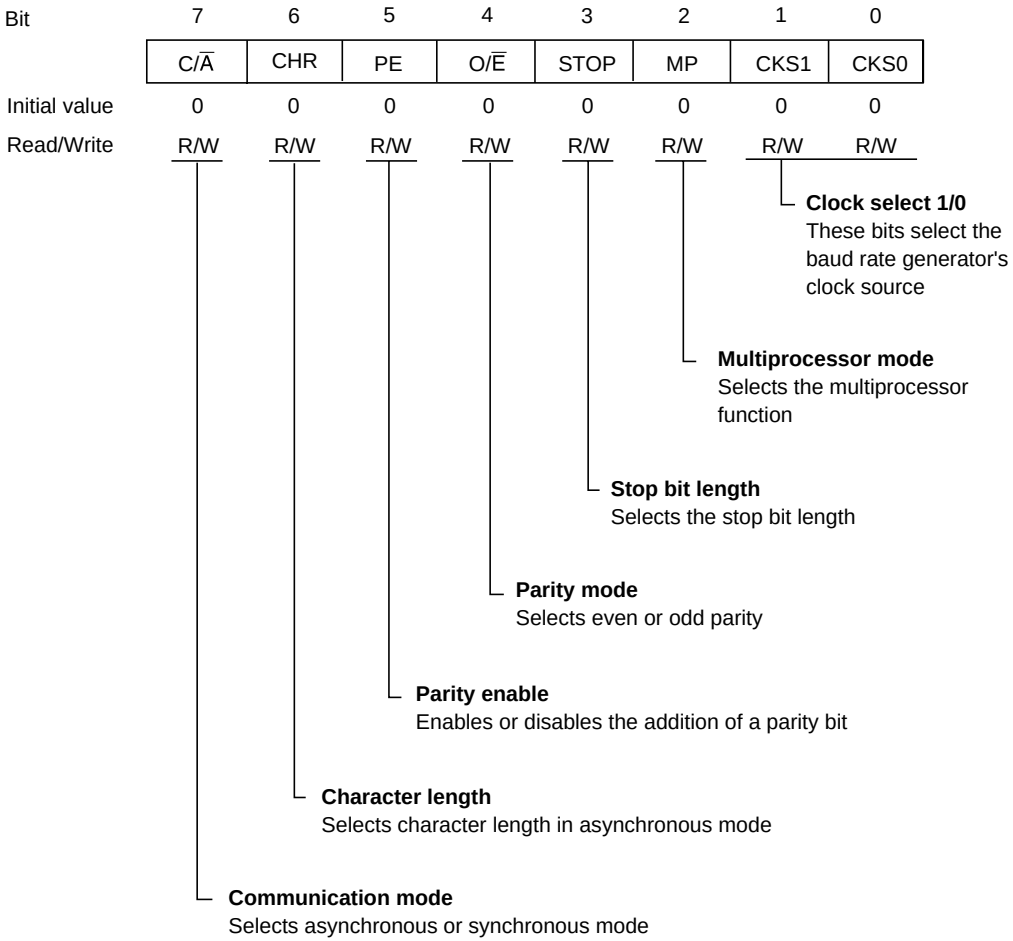


When the SCI detects that TSR is empty, it moves transmit data written in TDR from TDR into TSR and starts serial transmission. Continuous serial transmission is possible by writing the next transmit data in TDR during serial transmission from TSR.

The CPU can always read and write TDR. TDR is initialized to H'FF by a reset and in standby mode.

13.2.5 Serial Mode Register (SMR)

SMR is an 8-bit register that specifies the SCI's serial communication format and selects the clock source for the baud rate generator.



The CPU can always read and write SMR. SMR is initialized to H'00 by a reset and in standby mode.

Bit 7—Communication Mode (C/$\overline{A}$)/GSM Mode (GM): The function of this bit differs for the normal serial communication interface and for the smart card interface. Its function is switched with the SMIF bit in SCMR.

For serial communication interface (SMIF bit in SCMR cleared to 0): Selects whether the SCI operates in asynchronous or synchronous mode.

Bit 7 C/$\overline{A}$	Description	
0	Asynchronous mode	(Initial value)
1	Synchronous mode	

For smart card interface (SMIF bit in SCMR set to 1): Selects GSM mode for the smart card interface.

Bit 7 GM	Description	
0	The TEND flag is set 12.5 etu after the start bit	(Initial value)
1	The TEND flag is set 11.0 etu after the start bit	

Note: etu: Elementary time unit (time required to transmit one bit)

Bit 6—Character Length (CHR): Selects 7-bit or 8-bits data length in asynchronous mode. In synchronous mode, the data length is 8 bits regardless of the CHR setting.

Bit 6 CHR	Description	
0	8-bit data	(Initial value)
1	7-bit data*	

Note: * When 7-bit data is selected, the MSB (bit 7) of TDR is not transmitted.

Bit 5—Parity Enable (PE): In asynchronous mode, this bit enables or disables the addition of a parity bit to transmit data, and the checking of the parity bit in receive data. In synchronous mode, the parity bit is neither added nor checked, regardless of the PE bit setting.

Bit 5 PE	Description	
0	Parity bit not added or checked	(Initial value)
1	Parity bit added and checked*	

Note: * When PE bit is set to 1, an even or odd parity bit is added to transmit data according to the even or odd parity mode selection by the O/$\overline{E}$ bit, and the parity bit in receive data is checked to see that it matches the even or odd mode selected by the O/$\overline{E}$ bit.

Bit 4—Parity Mode (O/$\overline{E}$): Selects even or odd parity. The O/$\overline{E}$ bit setting is only valid when the PE bit is set to 1, enabling parity bit addition and checking, in asynchronous mode. The O/$\overline{E}$ bit setting is ignored in synchronous mode, or when parity addition and checking is disabled in asynchronous mode.

Bit 4 O/$\overline{E}$	Description	
0	Even parity*[1]	(Initial value)
1	Odd parity*[2]	

Notes: 1. When even parity is selected, the parity bit added to transmit data makes an even number of 1s in the transmitted character and parity bit combined. Receive data must have an even number of 1s in the received character and parity bit combined.
2. When odd parity is selected, the parity bit added to transmit data makes an odd number of 1s in the transmitted character and parity bit combined. Receive data must have an odd number of 1s in the received character and parity bit combined.

Bit 3—Stop Bit Length (STOP): Selects one or two stop bits in asynchronous mode. This setting is used only in asynchronous mode. In synchronous mode no stop bit is added, so the STOP bit setting is ignored.

Bit 3 STOP	Description	
0	1 stop bit*[1]	(Initial value)
1	2 stop bits*[2]	

Notes: 1. One stop bit (with value 1) is added to the end of each transmitted character.
2. Two stop bits (with value 1) are added to the end of each transmitted character.

In receiving, only the first stop bit is checked, regardless of the STOP bit setting. If the second stop bit is 1, it is treated as a stop bit. If the second stop bit is 0, it is treated as the start bit of the next incoming character.

Bit 2—Multiprocessor Mode (MP): Selects a multiprocessor format. When a multiprocessor format is selected, parity settings made by the PE and O/$\overline{E}$ bits are ignored. The MP bit setting is valid only in asynchronous mode. It is ignored in synchronous mode.

For further information on the multiprocessor communication function, see section 13.3.3, Multiprocessor Communication.

Bit 2 MP	Description	
0	Multiprocessor function disabled	(Initial value)
1	Multiprocessor format selected	

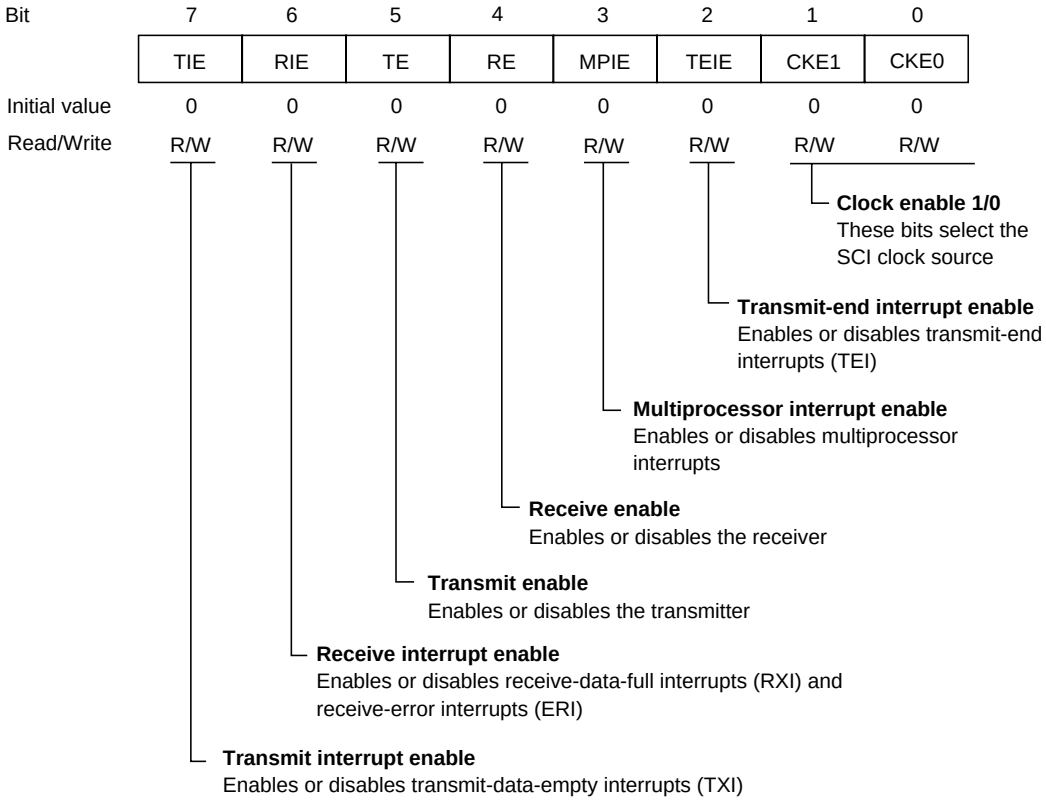
Bits 1 and 0—Clock Select 1 and 0 (CKS1/0): These bits select the clock source for the on-chip baud rate generator. Four clock sources are available: ϕ, $\phi/4$, $\phi/16$, and $\phi/64$.

For the relationship between the clock source, bit rate register setting, and baud rate, see section 13.2.8, Bit Rate Register (BRR).

Bit 1 CKS1	Bit 0 CKS0	Description
0	0	ϕ (Initial value)
0	1	$\phi/4$
1	0	$\phi/16$
1	1	$\phi/64$

13.2.6 Serial Control Register (SCR)

SCR register enables or disables the SCI transmitter and receiver, enables or disables serial clock output in asynchronous mode, enables or disables interrupts, and selects the transmit/receive clock source.



The CPU can always read and write SCR. SCR is initialized to H'00 by a reset and in standby mode.

Bit 7—Transmit Interrupt Enable (TIE): Enables or disables the transmit-data-empty interrupt (TXI) requested when the TDRE flag in SSR is set to 1 due to transfer of serial transmit data from TDR to TSR.

Bit 7 TIE	Description	
0	Transmit-data-empty interrupt request (TXI) is disabled*	(Initial value)
1	Transmit-data-empty interrupt request (TXI) is enabled	

Note: * TXI interrupt requests can be cleared by reading the value 1 from the TDRE flag, then clearing it to 0; or by clearing the TIE bit to 0.

Bit 6—Receive Interrupt Enable (RIE): Enables or disables the receive-data-full interrupt (RXI) requested when the RDRF flag in SSR is set to 1 due to transfer of serial receive data from RSR to RDR; also enables or disables the receive-error interrupt (ERI).

Bit 6 RIE	Description	
0	Receive-data-full (RXI) and receive-error (ERI) interrupt requests are disabled*	(Initial value)
1	Receive-data-full (RXI) and receive-error (ERI) interrupt requests are enabled	

Note: * RXI and ERI interrupt requests can be cleared by reading the value 1 from the RDRF, FER, PER, or ORER flag, then clearing the flag to 0; or by clearing the RIE bit to 0.

Bit 5—Transmit Enable (TE): Enables or disables the start of SCI serial transmitting operations.

Bit 5 TE	Description	
0	Transmitting disabled*[1]	(Initial value)
1	Transmitting enabled*[2]	

Notes: 1. The TDRE flag is fixed at 1 in SSR.
2. In the enabled state, serial transmission starts when the TDRE flag in SSR is cleared to 0 after writing of transmit data into TDR. Select the transmit format in SMR before setting the TE bit to 1.

Bit 4—Receive Enable (RE): Enables or disables the start of SCI serial receiving operations.

Bit 4 RE	Description	
0	Receiving disabled*[1]	(Initial value)
1	Receiving enabled*[2]	

Notes: 1. Clearing the RE bit to 0 does not affect the RDRF, FER, PER, and ORER flags. These flags retain their previous values.
2. In the enabled state, serial receiving starts when a start bit is detected in asynchronous mode, or serial clock input is detected in synchronous mode. Select the receive format in SMR before setting the RE bit to 1.

Bit 3—Multiprocessor Interrupt Enable (MPIE): Enables or disables multiprocessor interrupts. The MPIE bit setting is valid only in asynchronous mode, and only if the MP bit is set to 1 in SMR. The MPIE bit setting is ignored in synchronous mode or when the MP bit is cleared to 0.

Bit 3 MPIE	Description
0	Multiprocessor interrupts are disabled (normal receive operation) (Initial value) Clearing conditions (1) The MPIE bit is cleared to 0 (2) MPB = 1 in received data
1	Multiprocessor interrupts are enabled* Receive-data-full interrupts (RXI), receive-error interrupts (ERI), and setting of the RDRF, FER, and ORER status flags in SSR are disabled until data with the multiprocessor bit set to 1 is received.

Note: * The SCI does not transfer receive data from RSR to RDR, does not detect receive errors, and does not set the RDRF, FER, and ORER flags in SSR. When it receives data in which MPB = 1, the SCI sets the MPB bit to 1 in SSR, automatically clears the MPIE bit to 0, enables RXI and ERI interrupts (if the TIE and RIE bits in SCR are set to 1), and allows the FER and ORER flags to be set.

Bit 2—Transmit-End interrupt Enable (TEIE): Enables or disables the transmit-end interrupt (TEI) requested if TDR does not contain valid transmit data when the MSB is transmitted.

Bit 2 TEIE	Description	
0	Transmit-end interrupt requests (TEI) are disabled*	(Initial value)
1	Transmit-end interrupt requests (TEI) are enabled*	

Note: * TEI interrupt requests can be cleared by reading the value 1 from the TDRE flag in SSR, then clearing the TDRE flag to 0, thereby also clearing the TEND flag to 0; or by clearing the TEIE bit to 0.

Bits 1 and 0—Clock Enable 1 and 0 (CKE1/0): The function of these bits differs for the normal serial communication interface and for the smart card interface. Their function is switched with the SMIF bit in SCMR.

For serial communication interface (SMIF bit in SCMR cleared to 0): These bits select the SCI clock source and enable or disable clock output from the SCK pin. Depending on the settings of CKE1 and CKE0, the SCK pin can be used for generic input/output, serial clock output, or serial clock input.

The CKE0 setting is valid only in asynchronous mode, and only when the SCI is internally clocked (CKE1 = 0). The CKE0 setting is ignored in synchronous mode, or when an external clock source is selected (CKE1 = 1). Select the SCI operating mode in SMR before setting the CKE1 and CKE0 bits . For further details on selection of the SCI clock source, see table 13.9 in section 13.3, Operation.

Bit 1 CKE1	Bit 0 CKE0	Description	
0	0	Asynchronous mode	Internal clock, SCK pin available for generic input/output*[1]
		Synchronous mode	Internal clock, SCK pin used for serial clock output*[1]
0	1	Asynchronous mode	Internal clock, SCK pin used for clock output*[2]
		Synchronous mode	Internal clock, SCK pin used for serial clock output
1	0	Asynchronous mode	External clock, SCK pin used for clock input*[3]
		Synchronous mode	External clock, SCK pin used for serial clock input
1	1	Asynchronous mode	External clock, SCK pin used for clock input*[3]
		Synchronous mode	External clock, SCK pin used for serial clock input

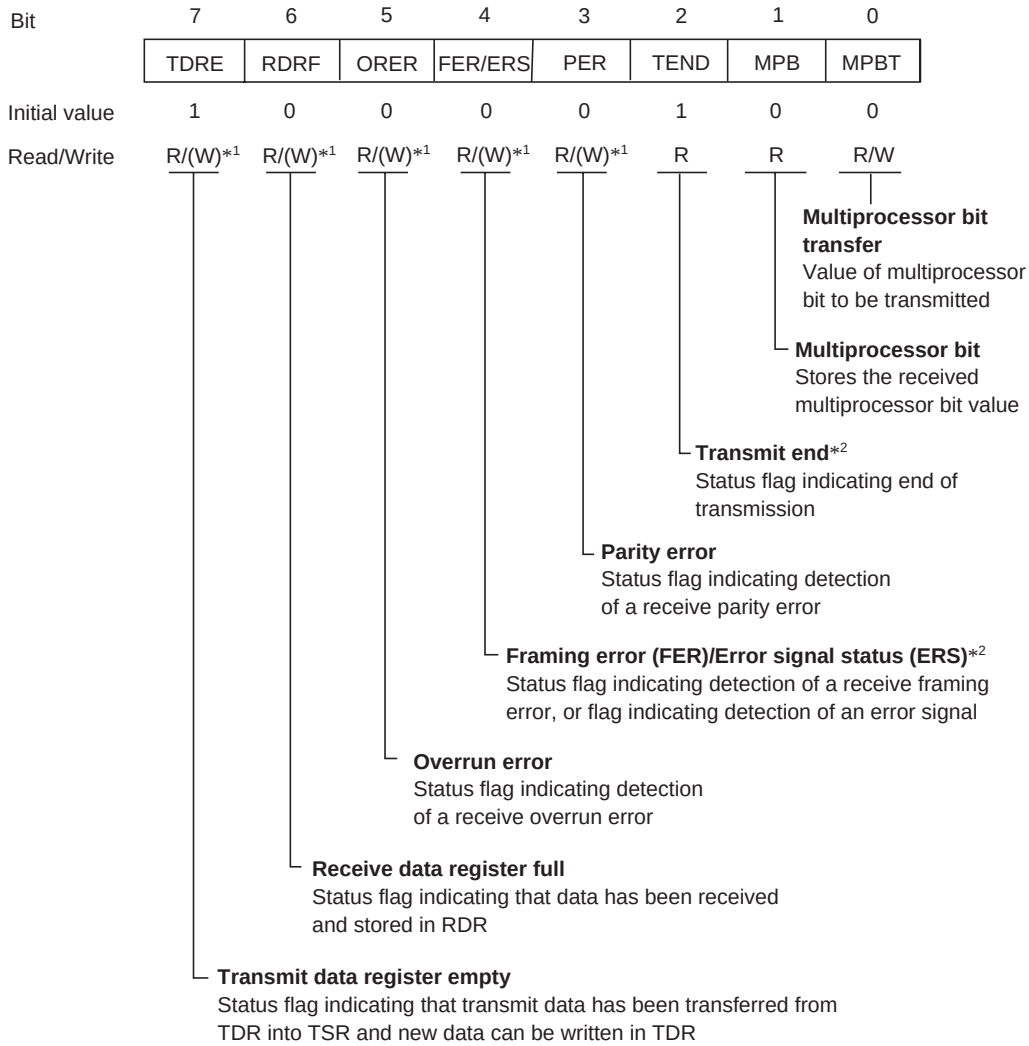
Notes: 1. Initial value
2. The output clock frequency is the same as the bit rate.
3. The input clock frequency is 16 times the bit rate.

For smart card interface (SMIF bit in SCMR set to 1): These bits, together with the GM bit in SMR, determine whether the SCK pin is used for generic input/output or as the serial clock output pin.

SMR GM	Bit 1 CKE1	Bit 0 CKE0	Description	
0	0	0	SCK pin available for generic input/output	(Initial value)
0	0	1	SCK pin used for clock output	
1	0	0	SCK pin output fixed low	
1	0	1	SCK pin used for clock output	
1	1	0	SCK pin output fixed high	
1	1	1	SCK pin used for clock output	

13.2.7 Serial Status Register (SSR)

SSR is an 8-bit register containing multiprocessor bit values, and status flags that indicate the operating status of the SCI.



Notes: 1. Only 0 can be written, to clear the flag.
2. Function differs between the normal serial communication interface and the smart card interface.

The CPU can always read and write SSR, but cannot write 1 in the TDRE, RDRF, ORER, PER, and FER flags. These flags can be cleared to 0 only if they have first been read while set to 1. The TEND and MPB flags are read-only bits that cannot be written.

SSR is initialized to H'84 by a reset and in standby mode.

Bit 7—Transmit Data Register Empty (TDRE): Indicates that the SCI has loaded transmit data from TDR into TSR and the next serial data can be written in TDR.

Bit 7 TDRE	Description
0	TDR contains valid transmit data [Clearing conditions] Read TDRE when TDRE = 1, then write 0 in TDRE The DMAC writes data in TDR
1	TDR does not contain valid transmit data (Initial value) [Setting conditions] The chip is reset or enters standby mode The TE bit in SCR is cleared to 0 TDR contents are loaded into TSR, so new data can be written in TDR

Bit 6—Receive Data Register Full (RDRF): Indicates that RDR contains new receive data.

Bit 6 RDRF	Description
0	RDR does not contain new receive data (Initial value) [Clearing conditions] The chip is reset or enters standby mode Read RDRF when RDRF = 1, then write 0 in RDRF The DMAC reads data from RDR
1	RDR contains new receive data [Setting condition] Serial data is received normally and transferred from RSR to RDR

Note: The RDR contents and the RDRF flag are not affected by detection of receive errors or by clearing of the RE bit to 0 in SCR. They retain their previous values. If the RDRF flag is still set to 1 when reception of the next data ends, an overrun error will occur and the receive data will be lost.

Bit 5—Overrun Error (ORER): Indicates that data reception ended abnormally due to an overrun error.

Bit 5 ORER	Description	
0	Receiving is in progress or has ended normally*[1] [Clearing conditions] The chip is reset or enters standby mode Read ORER when ORER = 1, then write 0 in ORER	(Initial value)
1	A receive overrun error occurred*[2] [Setting condition] Reception of the next serial data ends when RDRF = 1	

Notes: 1. Clearing the RE bit to 0 in SCR does not affect the ORER flag, which retains its previous value.

2. RDR continues to hold the receive data prior to the overrun error, so subsequent receive data is lost. Serial receiving cannot continue while the ORER flag is set to 1. In synchronous mode, serial transmitting is also disabled.

Bit 4—Framing Error (FER)/Error Signal Status (ERS): The function of this bit differs for the normal serial communication interface and for the smart card interface. Its function is switched with the SMIF bit in SCMR.

For serial communication interface (SMIF bit in SCMR cleared to 0): Indicates that data reception ended abnormally due to a framing error in asynchronous mode.

Bit 4 FER	Description	
0	Receiving is in progress or has ended normally*[1] [Clearing conditions] The chip is reset or enters standby mode Read FER when FER = 1, then write 0 in FER	(Initial value)
1	A receive framing error occurred*[2] [Setting condition] The stop bit at the end of the receive data is checked and found to be 0	

Notes: 1. Clearing the RE bit to 0 in SCR does not affect the FER flag, which retains its previous value.

2. When the stop bit length is 2 bits, only the first bit is checked. The second stop bit is not checked. When a framing error occurs the SCI transfers the receive data into RDR but does not set the RDRF flag. Serial receiving cannot continue while the FER flag is set to 1. In synchronous mode, serial transmitting is also disabled.

For smart card interface (SMIF bit in SCMR set to 1): Indicates the status of the error signal sent back from the receiving side during transmission. Framing errors are not detected in smart card interface mode.

Bit 4 ERS	Description
0	Normal reception, no error signal* (Initial value) [Clearing conditions] The chip is reset or enters standby mode Read ERS when ERS = 1, then write 0 in ERS
1	An error signal has been sent from the receiving side indicating detection of a parity error [Setting condition] The error signal is low when sampled

Note: * Clearing the TE bit to 0 in SCR does not affect the ERS flag, which retains its previous value.

Bit 3—Parity Error (PER): Indicates that data reception ended abnormally due to a parity error in asynchronous mode.

Bit 3 PER	Description
0	Receiving is in progress or has ended normally*[1] (Initial value) [Clearing conditions] The chip is reset or enters standby mode Read PER when PER = 1, then write 0 in PER
1	A receive parity error occurred*[2] [Setting condition] The number of 1s in receive data, including the parity bit, does not match the even or odd parity setting of O/$\overline{E}$ in SMR

Notes: 1. Clearing the RE bit to 0 in SCR does not affect the PER flag, which retains its previous value.

2. When a parity error occurs the SCI transfers the receive data into RDR but does not set the RDRF flag. Serial receiving cannot continue while the PER flag is set to 1. In synchronous mode, serial transmitting is also disabled.

Bit 2—Transmit End (TEND): The function of this bit differs for the normal serial communication interface and for the smart card interface. Its function is switched with the SMIF bit in SCMR.

For serial communication interface (SMIF bit in SCMR cleared to 0): Indicates that when the last bit of a serial character was transmitted TDR did not contain valid transmit data, so transmission has ended. The TEND flag is a read-only bit and cannot be written.

Bit 2 TEND	Description	
0	Transmission is in progress [Clearing conditions] Read TDRE when TDRE = 1, then write 0 in TDRE The DMAC writes data in TDR	
1	End of transmission [Setting conditions] The chip is reset or enters standby mode The TE bit in SCR is cleared to 0 TDRE is 1 when the last bit of a 1-byte serial transmit character is transmitted	(Initial value)

For smart card interface (SMIF bit in SCMR set to 1): Indicates that when the last bit of a serial character was transmitted TDR did not contain valid transmit data, so transmission has ended. The TEND flag is a read-only bit and cannot be written.

Bit 2 TEND	Description	
0	Transmission is in progress [Clearing conditions] Read TDRE when TDRE = 1, then write 0 in TDRE The DMAC writes data in TDR	
1	End of transmission [Setting conditions] The chip is reset or enters standby mode The TE bit is cleared to 0 in SCR and the FER/ERS bit is also cleared to 0 TDRE is 1 and FER/ERS is 0 (normal transmission) 2.5 etu (when GM = 0) or 1.0 etu (when GM = 1) after a 1-byte serial character is transmitted	(Initial value)

Note: etu: Elementary time unit (time required to transmit one bit)

Bit 1—Multiprocessor bit (MPB): Stores the value of the multiprocessor bit in the receive data when a multiprocessor format is used in asynchronous mode. MPB is a read-only bit, and cannot be written.

Bit 1 MPB	Description	
0	Multiprocessor bit value in receive data is 0*	(Initial value)
1	Multiprocessor bit value in receive data is 1	

Note: * If the RE bit in SCR is cleared to 0 when a multiprocessor format is selected, MPB retains its previous value.

Bit 0—Multiprocessor Bit Transfer (MPBT): Stores the value of the multiprocessor bit added to transmit data when a multiprocessor format in selected for transmitting in asynchronous mode.

The MPBT bit setting is ignored in synchronous mode, when a multiprocessor format is not selected, or when the SCI cannot transmit.

Bit 1 MPBT	Description	
0	Multiprocessor bit value in transmit data is 0	(Initial value)
1	Multiprocessor bit value in transmit data is 1	

13.2.8 Bit Rate Register (BRR)

BRR is an 8-bit register that, together with the CKS1 and CKS0 bits in SMR that select the baud rate generator clock source, determines the serial communication bit rate.

Bit	7	6	5	4	3	2	1	0
Initial value	1	1	1	1	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

The CPU can always read and write BRR. BRR is initialized to H'FF by a reset and in standby mode. Each SCI channel has independent baud rate generator control, so different values can be set in the three channels.

Table 13.3 shows examples of BRR settings in asynchronous mode. Table 13.4 shows examples of BRR settings in synchronous mode.

Table 13.3 Examples of Bit Rates and BRR Settings in Asynchronous Mode

Bit Rate (bit/s)	φ (MHz)											
	10			12			12.288			13		
	n	N	Error (%)	n	N	Error (%)	n	N	Error (%)	n	N	Error (%)
110	2	177	–0.25	2	212	0.03	2	217	0.08	2	230	–0.08
150	2	129	0.16	2	155	0.16	2	159	0.00	2	168	0.16
300	2	64	0.16	2	77	0.16	2	79	0.00	2	84	–0.43
600	1	129	0.16	1	155	0.16	1	159	0.00	1	168	0.16
1200	1	64	0.16	1	77	0.16	1	79	0.00	1	84	–0.43
2400	0	129	0.16	0	155	0.16	0	159	0.00	0	168	0.16
4800	0	64	0.16	0	77	0.16	0	79	0.00	0	84	–0.43
9600	0	32	–1.36	0	38	0.16	0	39	0.00	0	41	0.76
19200	0	15	1.73	0	19	–2.34	0	19	0.00	0	20	0.76
31250	0	9	0.00	0	11	0.00	0	11	2.40	0	12	0.00
38400	0	7	1.73	0	9	–2.34	0	9	0.00	0	10	–3.82

Bit Rate (bit/s)	φ (MHz)											
	14			14.7456			16			18		
	n	N	Error (%)	n	N	Error (%)	n	N	Error (%)	n	N	Error (%)
110	2	248	–0.17	3	64	0.70	3	70	0.03	3	79	–0.12
150	2	181	0.16	2	191	0.00	2	207	0.16	2	233	0.16
300	2	90	0.16	2	95	0.00	2	103	0.16	2	116	0.16
600	1	181	0.16	1	191	0.00	1	207	0.16	1	233	0.16
1200	1	90	0.16	1	95	0.00	1	103	0.16	1	116	0.16
2400	0	181	0.16	0	191	0.00	0	207	0.16	0	233	0.16
4800	0	90	0.16	0	95	0.00	0	103	0.16	0	116	0.16
9600	0	45	–0.93	0	47	0.00	0	51	0.16	0	58	–0.69
19200	0	22	–0.93	0	23	0.00	0	25	0.16	0	28	1.02
31250	0	13	0.00	0	14	–1.70	0	15	0.00	0	17	0.00
38400	0	10	3.57	0	11	0.00	0	12	0.16	0	14	–2.34

Bit Rate (bit/s)	φ (MHz)					
	20			25		
	n	N	Error (%)	n	N	Error (%)
110	3	88	–0.25	3	110	–0.02
150	3	64	0.16	3	80	0.47
300	2	129	0.16	2	162	–0.15
600	2	64	0.16	2	80	0.47
1200	1	129	0.16	1	162	–0.15
2400	1	64	0.16	1	80	0.47
4800	0	129	0.16	0	162	–0.15
9600	0	64	0.16	0	80	0.47
19200	0	32	–1.36	0	40	–0.76
31250	0	19	0.00	0	24	0.00
38400	0	15	1.73	0	19	1.73

Table 13.4 Examples of Bit Rates and BRR Settings in Synchronous Mode

Bit Rate (bit/s)	φ (MHz)											
	10		13		16		18		20		25	
	n	N	n	N	n	N	n	N	n	N	n	N
110	—	—	—	—	—	—	—	—	—	—	—	—
250	—	—	3	202	3	249	—	—	—	—	—	—
500	—	—	3	101	3	124	3	140	3	155	—	—
1k	—	—	2	202	2	249	3	69	3	77	3	97
2.5k	1	249	2	80	2	99	2	112	2	124	2	155
5k	1	124	1	162	1	199	1	224	1	249	2	77
10k	0	249	1	80	1	99	1	112	1	124	1	155
25k	0	99	0	129	0	159	0	179	0	199	0	249
50k	0	49	0	64	0	79	0	89	0	99	0	124
100k	0	24	—	—	0	39	0	44	0	49	0	62
250k	0	9	0	12	0	15	0	17	0	19	0	24
500k	0	4	—	—	0	7	0	8	0	9	—	—
1M	—	—	—	—	0	3	0	4	0	4	—	—
2M	—	—	—	—	0	1	—	—	—	—	—	—
2.5M	0	0*	—	—	—	—	—	—	—	—	—	—
4M					0	0*	—	—	—	—	—	—

Note: Settings with an error of 1% or less are recommended.

[Legend]

Blank : No setting available

— : Setting possible, but error occurs

* : Continuous transmission/reception not possible

The BRR setting is calculated as follows:

Asynchronous mode:

$$N = \frac{\phi}{64 \bullet 2^{2n-1} \bullet B} \bullet 10^6 - 1$$

Synchronous mode:

$$N = \frac{\phi}{8 \bullet 2^{2n-1} \bullet B} \bullet 10^6 - 1$$

B: Bit rate (bit/s)
N: BRR setting for baud rate generator ($0 \leq N \leq 255$)
ϕ: System clock frequency (MHz)
n: Baud rate generator clock source (n = 0, 1, 2, 3)
(For the clock sources and values of n, see the following table.)

		SMR Settings	
n	**Clock Source**	**CKS1**	**CKS0**
0	ϕ	0	0
1	ϕ/4	0	1
2	ϕ/16	1	0
3	ϕ/64	1	1

The bit rate error in asynchronous mode is calculated as follows:

$$\text{Error (\%)} = \left\{ \frac{\phi \bullet 10^6}{(N + 1) \bullet B \bullet 64 \bullet 2^{2n-1}} - 1 \right\} \bullet 100$$

Table 13.5 shows the maximum bit rates in asynchronous mode for various system clock frequencies. Table 13.6 and 13.7 shows the maximum bit rates with external clock input.

Table 13.5 Maximum Bit Rates for Various Frequencies (Asynchronous Mode)

		Settings	
ϕ (MHz)	**Maximum Bit Rate (bit/s)**	**n**	**N**
10	312500	0	0
12	375000	0	0
12.288	384000	0	0
14	437500	0	0
14.7456	460800	0	0
16	500000	0	0
17.2032	537600	0	0
18	562500	0	0
20	625000	0	0
25	781250	0	0

Table 13.6 Maximum Bit Rates with External Clock Input (Asynchronous Mode)

ϕ (MHz)	External Input Clock (MHz)	Maximum Bit Rate (bit/s)
10	2.5000	156250
12	3.0000	187500
12.288	3.0720	192000
14	3.5000	218750
14.7456	3.6864	230400
16	4.0000	250000
17.2032	4.3008	268800
18	4.5000	281250
20	5.0000	312500
25	6.2500	390625

Table 13.7 Maximum Bit Rates with External Clock Input (Synchronous Mode)

ϕ (MHz)	External Input Clock (MHz)	Maximum Bit Rate (bit/s)
10	1.6667	1666666.7
12	2.0000	2000000.0
14	2.3333	2333333.3
16	2.6667	2666666.7
18	3.0000	3000000.0
20	3.3333	3333333.3
25	4.1667	4166666.7

13.3 Operation

13.3.1 Overview

The SCI can carry out serial communication in two modes: asynchronous mode in which synchronization is achieved character by character, and synchronous mode in which synchronization is achieved with clock pulses. A smart card interface is also supported as a serial communication function for an IC card interface.

Selection of asynchronous or synchronous mode and the transmission format for the normal serial communication interface is made in SMR, as shown in table 13.8. The SCI clock source is selected by the C/$\overline{A}$ bit in SMR and the CKE1 and CKE0 bits in SCR, as shown in table 13.9.

For details of the procedures for switching between LSB-first and MSB-first mode and inverting the data logic level, see section 14.2.1, Smart Card Mode Register (SCMR).

For selection of the smart card interface format, see section 14.3.3, Data Format.

Asynchronous Mode

- Data length is selectable: 7 or 8 bits
- Parity and multiprocessor bits are selectable, and so is the stop bit length (1 or 2 bits). These selections determine the communication format and character length.
- In receiving, it is possible to detect framing errors, parity errors, overrun errors, and the break state.
- An internal or external clock can be selected as the SCI clock source.
  - — When an internal clock is selected, the SCI operates using the on-chip baud rate generator, and can output a serial clock signal with a frequency matching the bit rate.
  - — When an external clock is selected, the external clock input must have a frequency 16 times the bit rate. (The on-chip baud rate generator is not used.)

Synchronous Mode

- The communication format has a fixed 8-bit data length.
- In receiving, it is possible to detect overrun errors.
- An internal or external clock can be selected as the SCI clock source.
  - — When an internal clock is selected, the SCI operates using the on-chip baud rate generator, and can output a serial clock signal to external devices.
  - — When an external clock is selected, the SCI operates on the input serial clock. The on-chip baud rate generator is not used.

- One frame consists of 8-bit data and a parity bit.
- In transmitting, a guard time of at least two elementary time units (2 etu) is provided between the end of the parity bit and the start of he next frame. (An elementary time unit is the time required to transmit one bit.)
- In receiving, if a parity error is detected, a low error signal level is output for 1 etu, beginning 10.5 etu after the start bit.
- In transmitting, if an error signal is received, the same data is automatically transmitted again after at least 2 etu.
- Only asynchronous communication is supported. There is no synchronous communication function.

For details of smart card interface operation, see section 14, Smart Card Interface.

Table 13.8 SMR Settings and Serial Communication Formats

SMR Settings						SCI Communication Format			
Bit 7 C/$\overline{A}$	**Bit 6 CHR**	**Bit 2 MP**	**Bit 5 PE**	**Bit 3 STOP**	**Mode**	**Data Length**	**Multi-processor Bit**	**Parity Bit**	**Stop Bit Length**
0	0	0	0	0	Asyn-chronous mode	8-bit data	Absent	Absent	1 bit
				1					2 bits
			1	0				Present	1 bit
				1					2 bits
	1		0	0		7-bit data		Absent	1 bit
				1					2 bits
			1	0				Present	1 bit
				1					2 bits
	0	1	—	0	Asyn-chronous mode (multi-processor format)	8-bit data	Present	Absent	1 bit
			—	1					2 bits
	1		—	0		7-bit data			1 bit
			—	1					2 bits
1	—	—	—	—	Syn-chronous mode	8-bit data	Absent		None

Table 13.9 SMR and SCR Settings and SCI Clock Source Selection

SMR	SCR Setting			SCI Transmit/Receive clock	
Bit 7 C/$\overline{A}$	Bit 1 CKE1	Bit 0 CKE0	Mode	Clock Source	SCK Pin Function
0	0	0	Asynchronous mode	Internal	SCI does not use the SCK pin
		1			Outputs clock with frequency matching the bit rate
	1	0		External	Inputs clock with frequency 16 times the bit rate
		1			
1	0	0	Synchronous mode	Internal	Outputs the serial clock
		1			
	1	0		External	Inputs the serial clock
		1			

13.3.2 Operation in Asynchronous Mode

In asynchronous mode, each transmitted or received character begins with a start bit and ends with one or two stop bits. Serial communication is synchronized one character at a time.

The transmitting and receiving sections of the SCI are independent, so full-duplex communication is possible. The transmitter and the receiver are both double-buffered, so data can be written and read while transmitting and receiving are in progress, enabling continuous transmitting and receiving.

Figure 13.2 shows the general format of asynchronous serial communication. In asynchronous serial communication the communication line is normally held in the mark (high) state. The SCI monitors the line and starts serial communication when the line goes to the space (low) state, indicating a start bit. One serial character consists of a start bit (low), data (LSB first), parity bit (high or low), and one or two stop bits (high), in that order.

When receiving in asynchronous mode, the SCI synchronizes at the falling edge of the start bit. The SCI samples each data bit on the eighth pulse of a clock with a frequency 16 times the bit rate. Receive data is latched at the center of each bit.

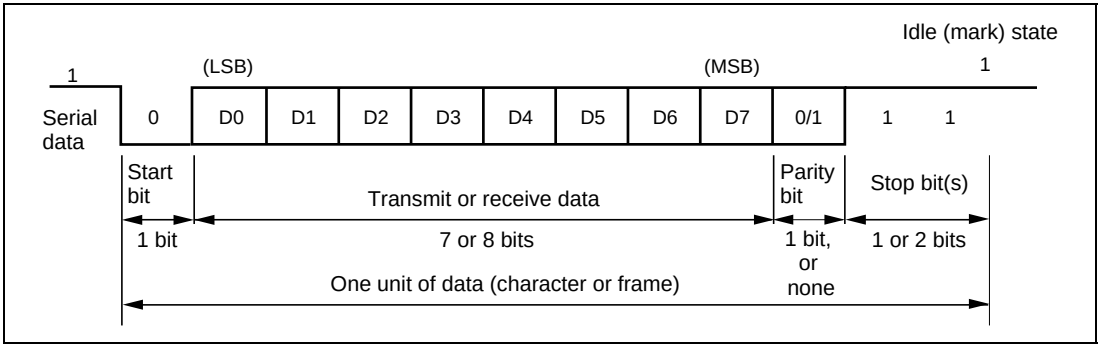


Figure 13.2 Data Format in Asynchronous Communication (Example: 8-Bit Data with Parity and 2 Stop Bits)

Communication Formats: Table 13.10 shows the 12 communication formats that can be selected in asynchronous mode. The format is selected by settings in SMR.

Table 13.10 Serial Communication Formats (Asynchronous Mode)

SMR Settings				Serial Communication Format and Frame Length
CHR	PE	MP	STOP	1 2 3 4 5 6 7 8 9 10 11 12
0	0	0	0	S 8-bit data STOP
0	0	0	1	S 8-bit data STOP STOP
0	1	0	0	S 8-bit data P STOP
0	1	0	1	S 8-bit data P STOP STOP
1	0	0	0	S 7-bit data STOP
1	0	0	1	S 7-bit data STOP STOP
1	1	0	0	S 7-bit data P STOP
1	1	0	1	S 7-bit data P STOP STOP
0	—	1	0	S 8-bit data MPB STOP
0	—	1	1	S 8-bit data MPB STOP STOP
1	—	1	0	S 7-bit data MPB STOP
1	—	1	1	S 7-bit data MPB STOP STOP

[Legend]

S: Start bit

STOP: Stop bit

P: Parity bit

MPB: Multiprocessor bit

Clock: An internal clock generated by the on-chip baud rate generator or an external clock input from the SCK pin can be selected as the SCI transmit/receive clock. The clock source is selected by the C/$\overline{A}$ bit in SMR and bits CKE1 and CKE0 in SCR. For details of SCI clock source selection, see table 13.9.

When an external clock is input at the SCK pin, it must have a frequency 16 times the desired bit rate.

When the SCI is operated on an internal clock, it can output a clock signal at the SCK pin. The frequency of this output clock is equal to the bit rate. The phase is aligned as shown in figure 13.3 so that the rising edge of the clock occurs at the center of each transmit data bit.

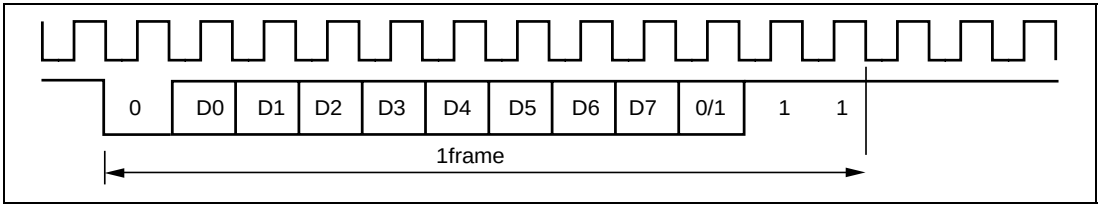


Figure 13.3 Phase Relationship between Output Clock and Serial Data (Asynchronous Mode)

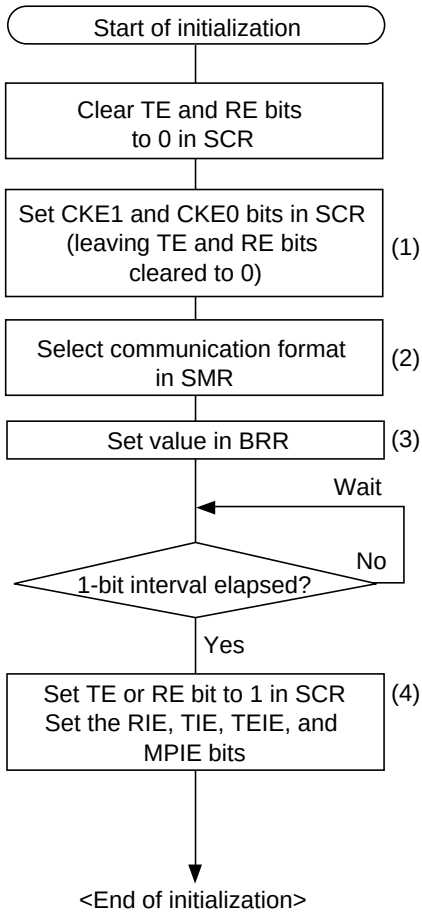
Transmitting and Receiving Data:

- SCI Initialization (Asynchronous Mode): Before transmitting or receiving data, clear the TE and RE bits to 0 in SCR, then initialize the SCI as follows.

  When changing the communication mode or format, always clear the TE and RE bits to 0 before following the procedure given below. Clearing TE to 0 sets the TDRE flag to 1 and initializes TSR. Clearing RE to 0, however, does not initialize the RDRF, PER, FER, and ORER flags, or RDR, which retain their previous contents.

  When an external clock is used the clock should not be stopped during initialization or subsequent operation, since operation will be unreliable in this case.

Figure 13.4 shows a sample flowchart for initializing the SCI.



(1) Set the clock source in SCR. Clear the RIE, TIE, TEIE, MPIE, TE, and RE bits to 0. If clock output is selected in asynchronous mode, clock output starts immediately after the setting is made in SCR.

(2) Select the communication format in SMR.

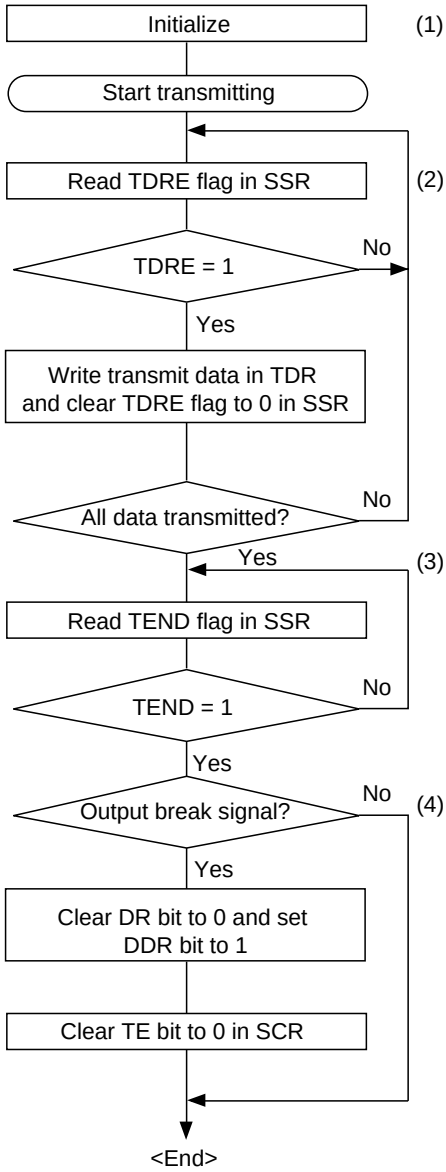
(3) Write the value corresponding to the bit rate in BRR.
This step is not necessary when an external clock is used.

(4) Wait for at least the interval required to transmit or receive one bit, then set the TE or RE bit to 1 in SCR. Set the RIE, TIE, TEIE, and MPIE bits as necessary. Setting the TE or RE bit enables the SCI to use the TxD or RxD pin.

Note: In simultaneous transmitting and receiving, the TE and RE bits should be cleared to 0 or set to 1 simultaneously.

Figure 13.4 Sample Flowchart for SCI Initialization

- Transmitting Serial Data (Asynchronous Mode): Figure 13.5 shows a sample flowchart for transmitting serial data and indicates the procedure to follow.



(1) SCI initialization:
the transmit data output function of the TxD pin is selected automatically.
Transmission is possible after the TE bit is set to 1 and 1 is output for one frame.

(2) SCI status check and transmit data write:
read SSR and check that the TDRE flag is set to 1, then write transmit data in TDR and clear the TDRE flag to 0.

(3) To continue transmitting serial data:
after checking that the TDRE flag is 1, indicating that data can be written, write data in TDR, then clear the TDRE flag to 0. When the DMAC is activated by a transmit-data-empty interrupt request (TXI) to write data in TDR, the TDRE flag is checked and cleared automatically.

(4) To output a break signal at the end of serial transmission:
set the DDR bit to 1 and clear the DR bit to 0, then clear the TE bit to 0 in SCR.

Figure 13.5 Sample Flowchart for Transmitting Serial Data

In transmitting serial data, the SCI operates as follows:

- The SCI monitors the TDRE flag in SSR. When the TDRE flag is cleared to 0, the SCI recognizes that TDR contains new data, and loads this data from TDR into TSR.
- After loading the data from TDR to TSR, the SCI sets the TDRE flag to 1 and starts transmitting. If the TIE bit is set to 1 in SCR, the SCI requests a transmit-data-empty interrupt (TXI) at this time.

  Serial transmit data is transmitted in the following order from the TxD pin:

  — Start bit: One 0 bit is output.

  — Transmit data: 7 or 8 bits are output, LSB first.

  — Parity bit or multiprocessor bit: One parity bit (even or odd parity),or one multiprocessor bit is output. Formats in which neither a parity bit nor a multiprocessor bit is output can also be selected.

  — Stop bit(s): One or two 1 bits (stop bits) are output.

  — Mark state: Output of 1 bits continues until the start bit of the next transmit data.
- The SCI checks the TDRE flag when it outputs the stop bit. If the TDRE flag is 0, the SCI loads new data from TDR into TSR, outputs the stop bit, then begins serial transmission of the next frame. If the TDRE flag is 1, the SCI sets the TEND flag to 1 in SSR, outputs the stop bit, then continues output of 1 bits in the mark state. If the TEIE bit is set to 1 in SCR, a transmit-end interrupt (TEI) is requested at this time.

  Figure 13.6 shows an example of SCI transmit operation in asynchronous mode.

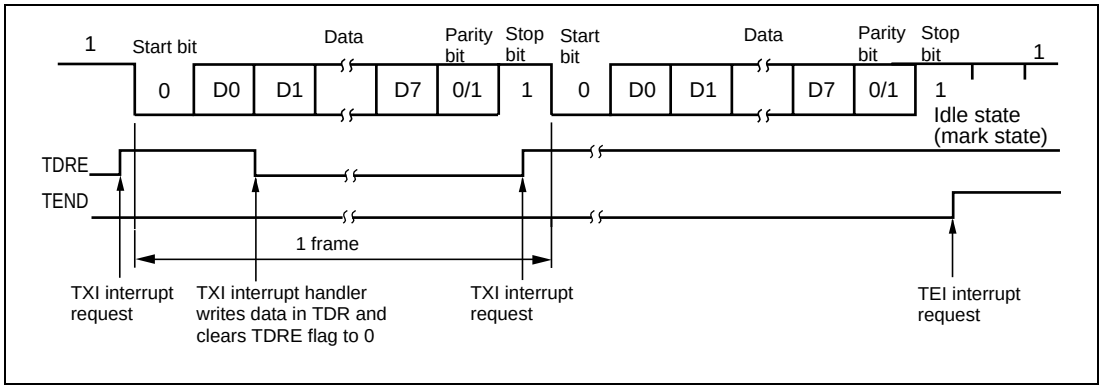


Figure 13.6 Example of SCI Transmit Operation in Asynchronous Mode (8-Bit Data with Parity and One Stop Bit)

- Receiving Serial Data (Asynchronous Mode): Figure 13.7 shows a sample flowchart for receiving serial data and indicates the procedure to follow.

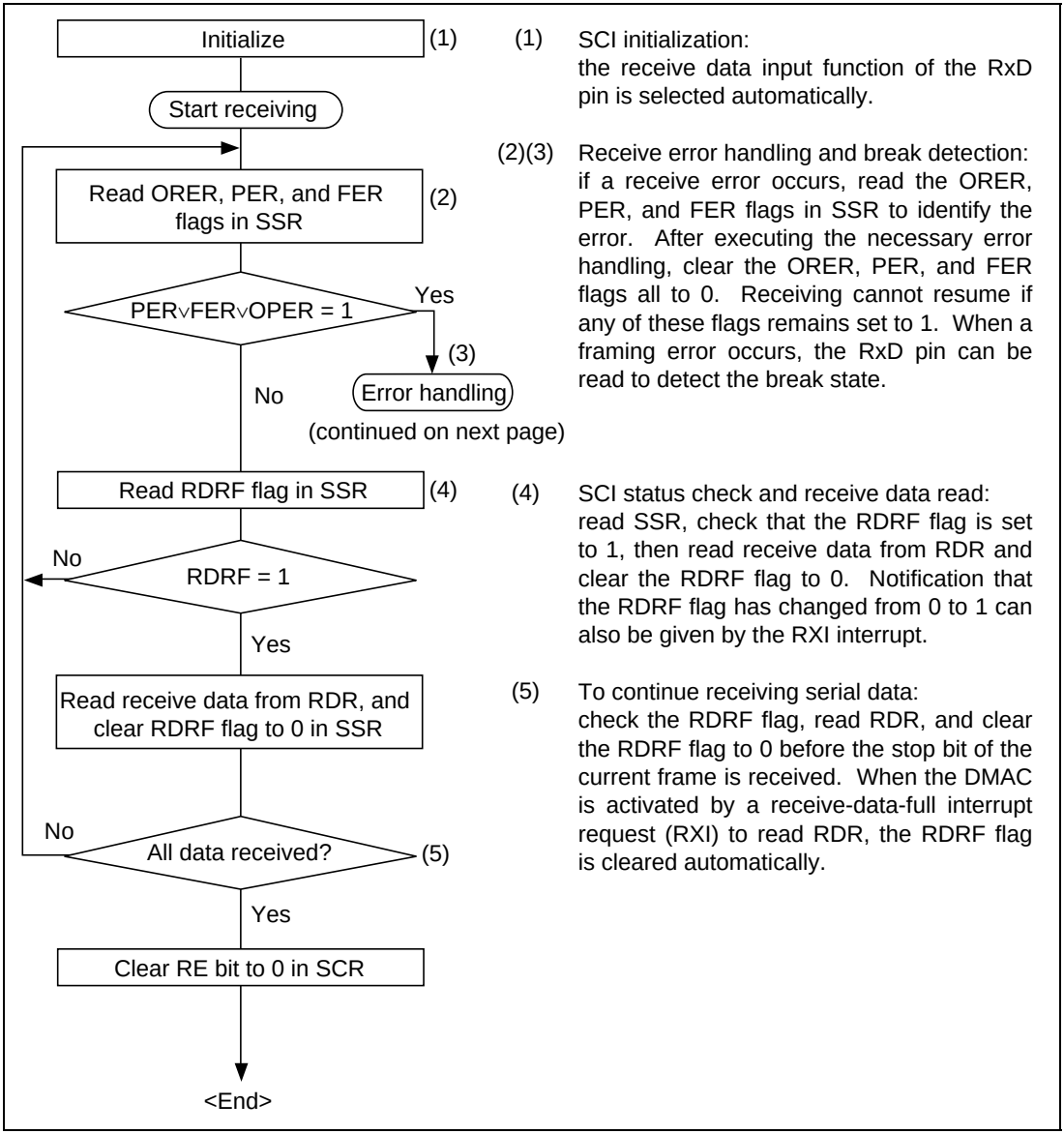


Figure 13.7 Sample Flowchart for Receiving Serial Data (1)

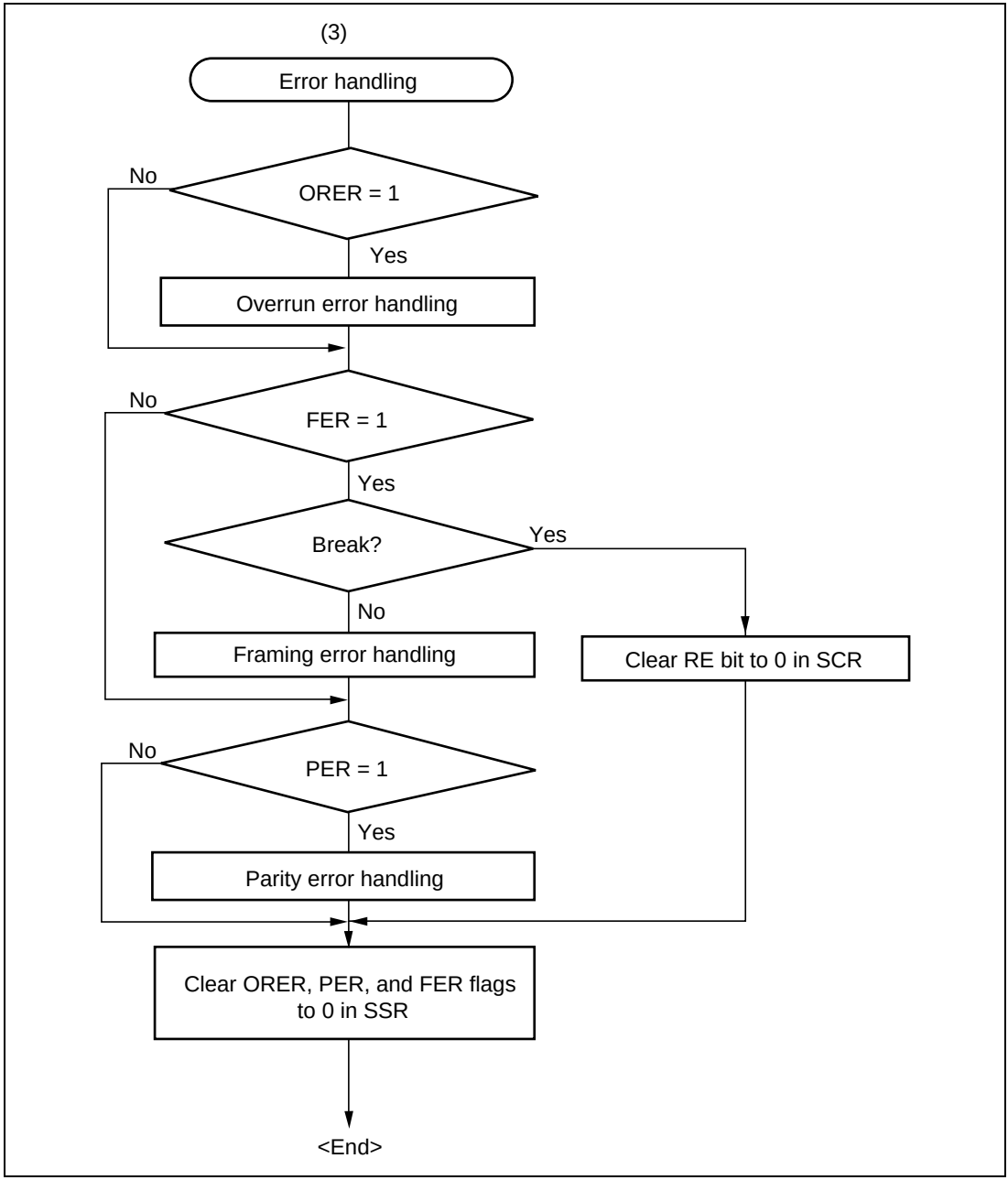


Figure 13.7 Sample Flowchart for Receiving Serial Data (2)

In receiving, the SCI operates as follows:

- The SCI monitors the communication line. When it detects a start bit (0 bit), the SCI synchronizes internally and starts receiving.
- Receive data is stored in RSR in order from LSB to MSB.
- The parity bit and stop bit are received.

  After receiving these bits, the SCI carries out the following checks:

  — Parity check: The number of 1s in the receive data must match the even or odd parity setting of in the O/$\overline{E}$ bit in SMR.

  — Stop bit check: The stop bit value must be 1. If there are two stop bits, only the first is checked.

  — Status check: The RDRF flag must be 0, indicating that the receive data can be transferred from RSR into RDR.

  If these all checks pass, the RDRF flag is set to 1 and the received data is stored in RDR. If one of the checks fails (receive error*), the SCI operates as shown in table 13.11.

Note: * When a receive error occurs, further receiving is disabled. In receiving, the RDRF flag is not set to 1. Be sure to clear the error flags to 0.

- When the RDRF flag is set to 1, if the RIE bit is set to 1 in SCR, a receive-data-full interrupt (RXI) is requested. If the ORER, PER, or FER flag is set to 1 and the RIE bit in SCR is also set to 1, a receive-error interrupt (ERI) is requested.

Table 13.11 Receive Error Conditions

Receive Error	Abbreviation	Condition	Data Transfer
Overrun error	ORER	Receiving of next data ends while RDRF flag is still set to 1 in SSR	Receive data is not transferred from RSR to RDR
Framing error	FER	Stop bit is 0	Receive data is transferred from RSR to RDR
Parity error	PER	Parity of received data differs from even/odd parity setting in SMR	Receive data is transferred from RSR to RDR

Figure 13.8 shows an example of SCI receive operation in asynchronous mode.

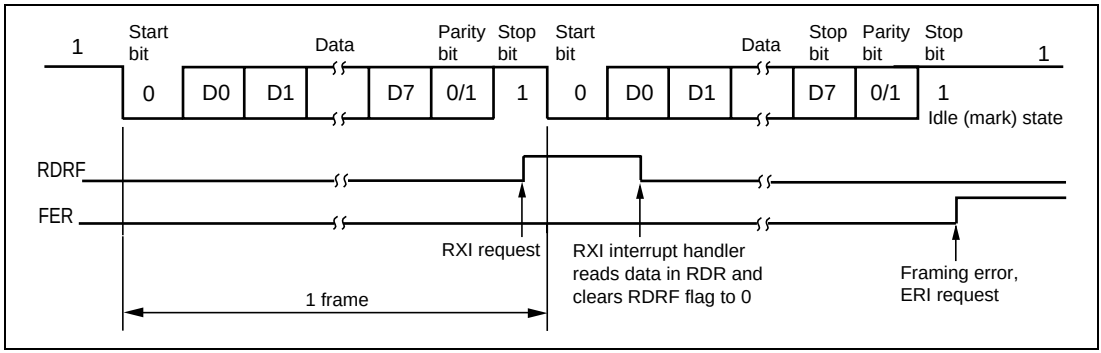


Figure 13.8 Example of SCI Receive Operation (8-Bit Data with Parity and One Stop Bit)

13.3.3 Multiprocessor Communication

The multiprocessor communication function enables several processors to share a single serial communication line. The processors communicate in asynchronous mode using a format with an additional multiprocessor bit (multiprocessor format).

In multiprocessor communication, each receiving processor is addressed by an ID. A serial communication cycle consists of an ID-sending cycle that identifies the receiving processor, and a data-sending cycle. The multiprocessor bit distinguishes ID-sending cycles from data-sending cycles.

The transmitting processor stars by sending the ID of the receiving processor with which it wants to communicate as data with the multiprocessor bit set to 1. Next the transmitting processor sends transmit data with the multiprocessor bit cleared to 0.

Receiving processors skip incoming data until they receive data with the multiprocessor bit set to 1. When they receive data with the multiprocessor bit set to 1, receiving processors compare the data with their IDs. Processors with IDs not matching the received data skip further incoming data until they again receive data with the multiprocessor bit set to 1. Multiple processors can send and receive data in this way.

Figure 13.9 shows an example of communication among different processors using a multiprocessor format.

Communication Formats: Four formats are available. Parity bit settings are ignored when a multiprocessor format is selected. For details see table 13.10.

Clock: See the description of asynchronous mode.

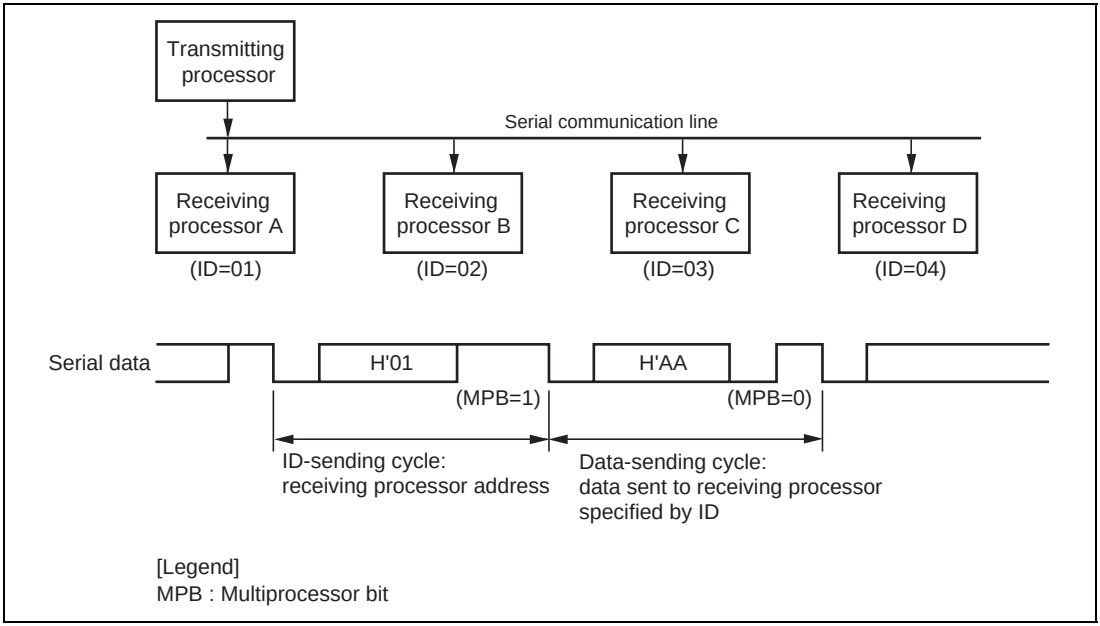
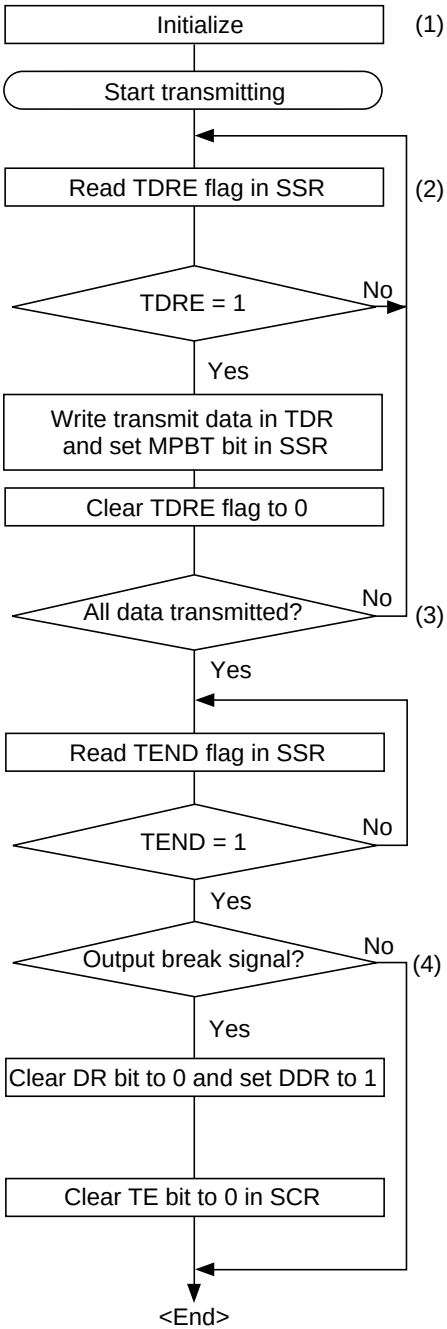


Figure 13.9 Example of Communication among Processors using Multiprocessor Format (Sending Data H'AA to Receiving Processor A)

Transmitting and Receiving Data:

- Transmitting Multiprocessor Serial Data: Figure 13.10 shows a sample flowchart for transmitting multiprocessor serial data and indicates the procedure to follow.



(1) SCI initialization:
the transmit data output function of the TxD pin is selected automatically.

(2) SCI status check and transmit data write:
read SSR, check that the TDRE flag is 1, then write transmit data in TDR. Also set the MPBT flag to 0 or 1 in SSR. Finally, clear the TDRE flag to 0.

(3) To continue transmitting serial data:
after checking that the TDRE flag is 1, indicating that data can be written, write data in TDR, then clear the TDRE flag to 0. When the DMAC is activated by a transmit-data-empty interrupt request (TXI) to write data in TDR, the TDRE flag is checked and cleared automatically.

(4) To output a break signal at the end of serial transmission:
set the DDR bit to 1 and clear the DR bit to 0, then clear the TE bit to 0 in SCR.

Figure 13.10 Sample Flowchart for Transmitting Multiprocessor Serial Data

In transmitting serial data, the SCI operates as follows:

- The SCI monitors the TDRE flag in SSR. When the TDRE flag is cleared to 0, the SCI recognizes that TDR contains new data, and loads this data from TDR into TSR.
- After loading the data from TDR to TSR, the SCI sets the TDRE flag to 1 and starts transmitting. If the TIE bit is set to 1 in SCR, the SCI requests a transmit-data-empty interrupt (TXI) at this time.

  Serial transmit data is transmitted in the following order from the TxD pin:

  — Start bit: One 0 bit is output.

  — Transmit data: 7 or 8 bits are output, LSB first.

  — Multiprocessor bit: One multiprocessor bit (MPBT value) is output.

  — Stop bit(s): One or two 1 bits (stop bits) are output.

  — Mark state: Output of 1 bits continues until the start bit of the next transmit data.
- The SCI checks the TDRE flag when it outputs the stop bit. If the TDRE flag is 0, the SCI loads new data from TDR into TSR, outputs the stop bit, then begins serial transmission of the next frame. If the TDRE flag is 1, the SCI sets the TEND flag to 1 in SSR, outputs the stop bit, then continues output of 1 bits in the mark state. If the TEIE bit is set to 1 in SCR, a transmit-end interrupt (TEI) is requested at this time.

Figure 13.11 shows an example of SCI transmit operation using a multiprocessor format.

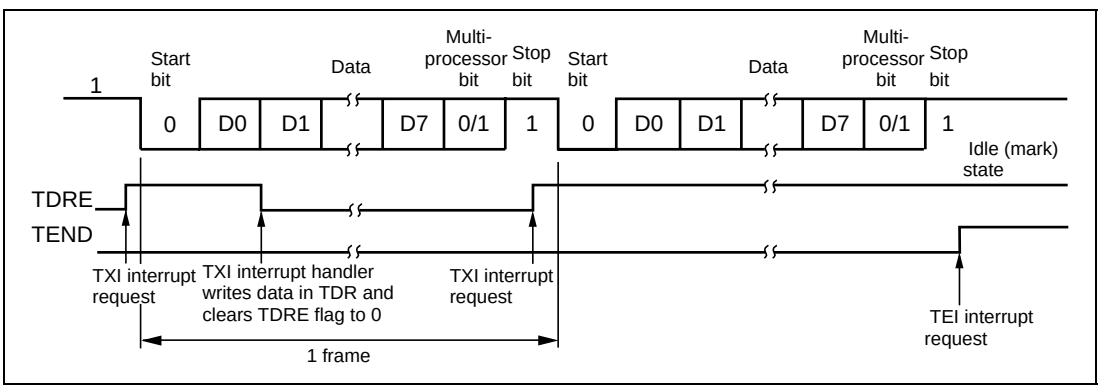
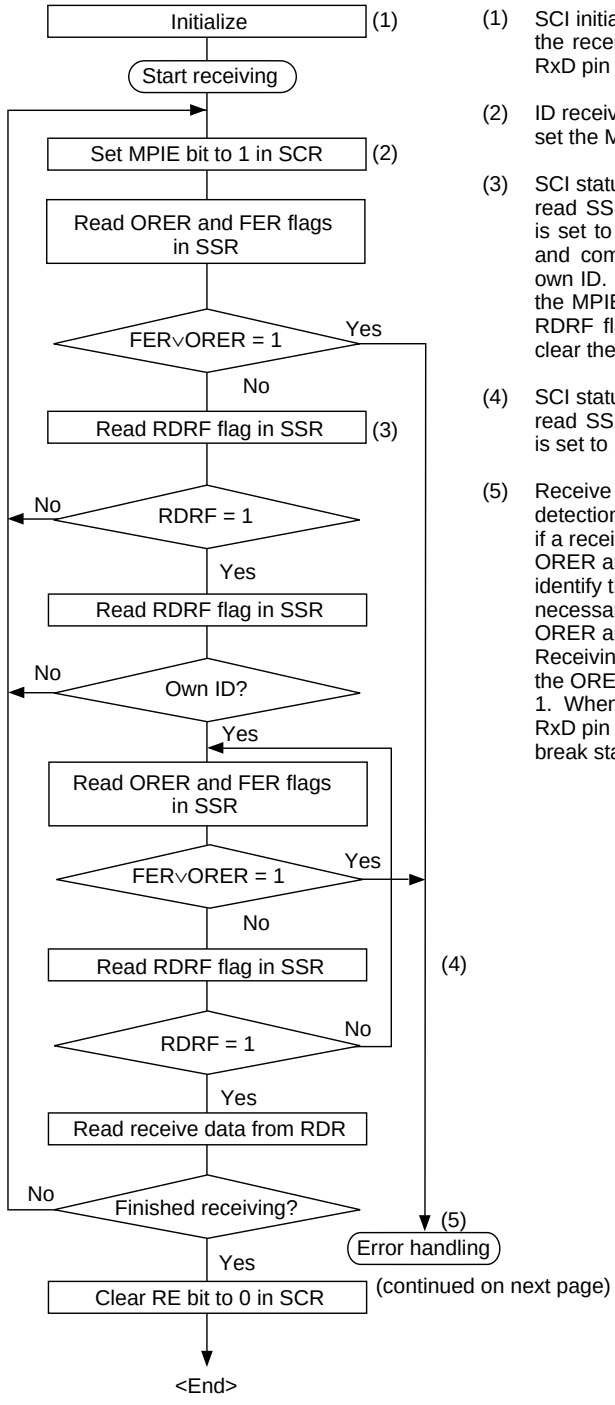


Figure 13.11 Example of SCI Transmit Operation (8-Bit Data with Multiprocessor Bit and One Stop Bit)

- Receiving Multiprocessor Serial Data: Figure 13.12 shows a sample flowchart for receiving multiprocessor serial data and indicates the procedure to follow.



(1) SCI initialization:
the receive data input function of the RxD pin is selected automatically.

(2) ID receive cycle:
set the MPIE bit to 1 in SCR.

(3) SCI status check and ID check:
read SSR, check that the RDRF flag is set to 1, then read data from RDR and compare it with the processor's own ID. If the ID does not match, set the MPIE bit to 1 again and clear the RDRF flag to 0. If the ID matches, clear the RDRF flag to 0.

(4) SCI status check and data receiving:
read SSR, check that the RDRF flag is set to 1, then read data from RDR.

(5) Receive error handling and break detection:
if a receive error occurs, read the ORER and FER flags in SSR to identify the error. After executing the necessary error handling, clear the ORER and FER flags both to 0. Receiving cannot resume while either the ORER or FER flag remains set to 1. When a framing error occurs, the RxD pin can be read to detect the break state.

Figure 13.12 Sample Flowchart for Receiving Multiprocessor Serial Data (1)

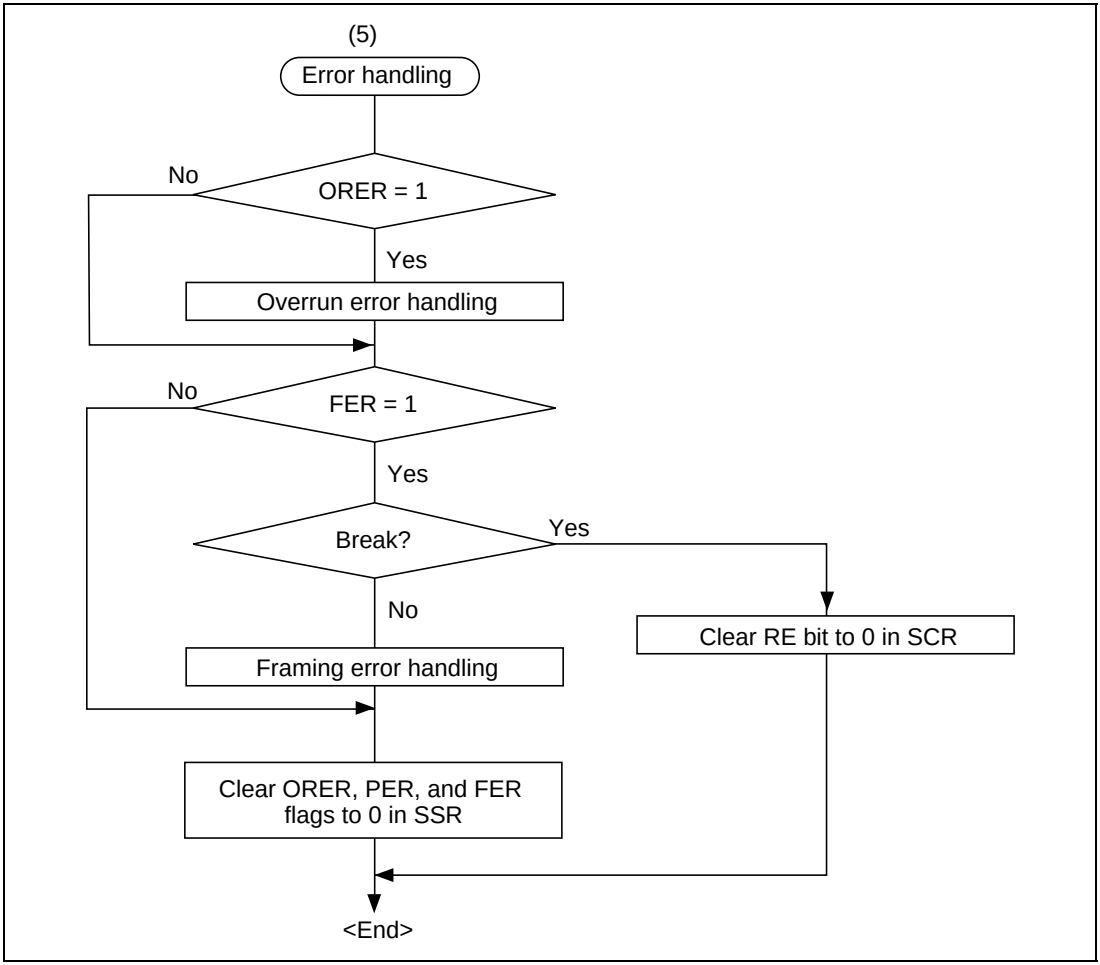


Figure 13.12 Sample Flowchart for Receiving Multiprocessor Serial Data (2)

Figure 13.13 shows an example of SCI receive operation using a multiprocessor format.

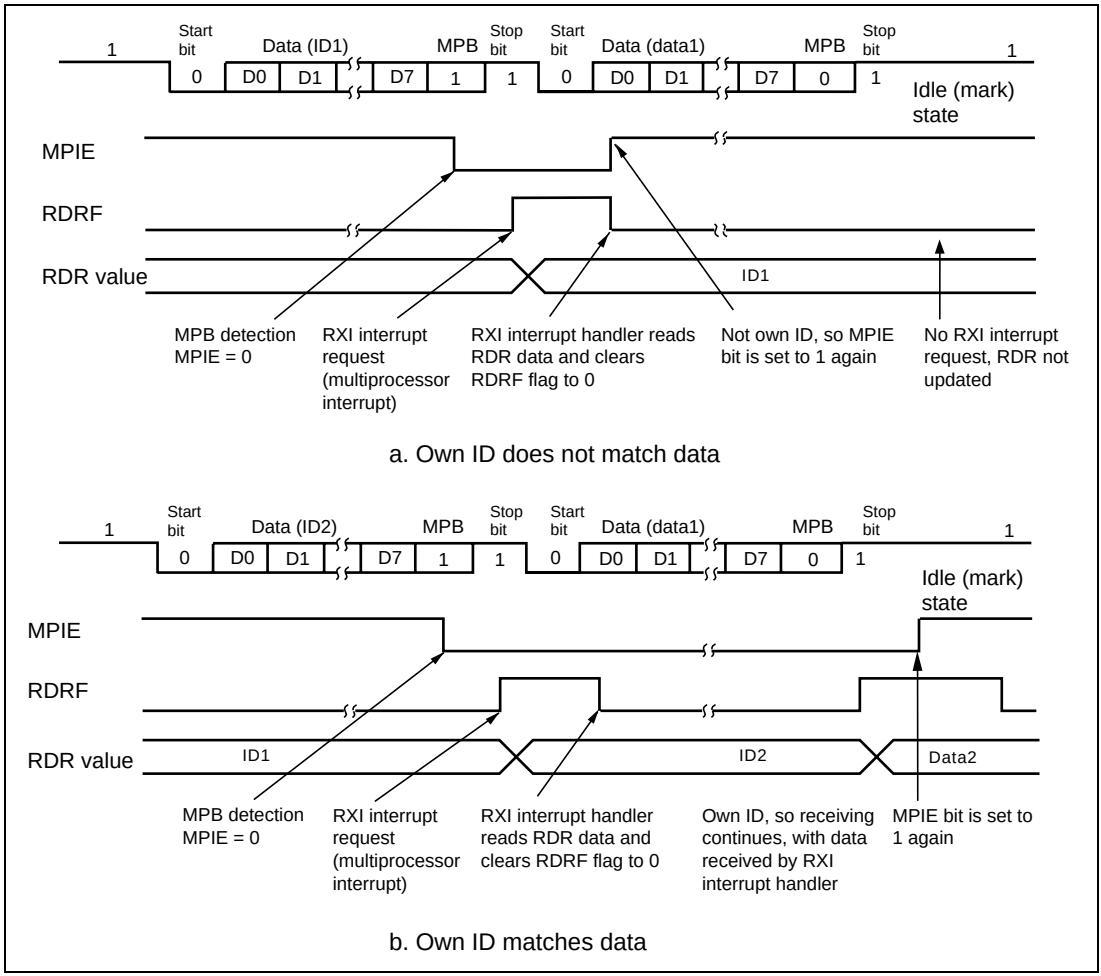


Figure 13.13 Example of SCI Receive Operation (8-Bit Data with Multiprocessor Bit and One Stop Bit)

13.3.4 Synchronous Operation

In synchronous mode, the SCI transmits and receives data in synchronization with clock pulses. This mode is suitable for high-speed serial communication.

The SCI transmitter and receiver share the same clock but are otherwise independent, so full-duplex communication is possible. The transmitter and the receiver are also double-buffered, so continuous transmitting or receiving is possible by reading or writing data while transmitting or receiving is in progress.

Figure 13.14 shows the general format in synchronous serial communication.

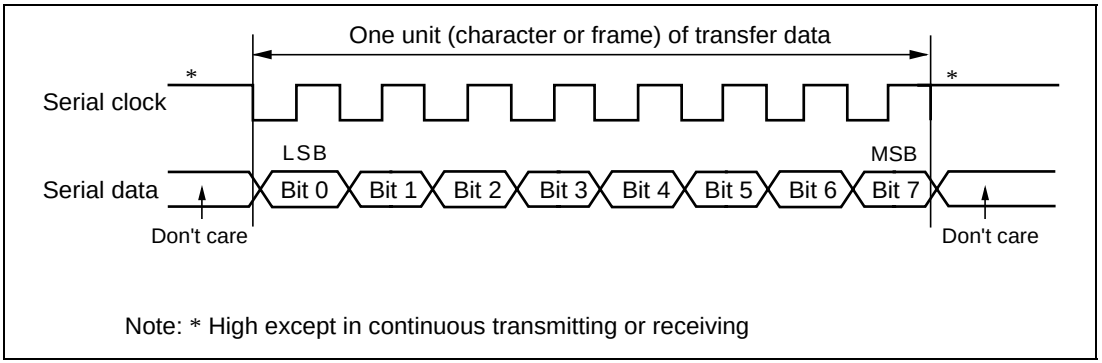


Figure 13.14 Data Format in Synchronous Communication

In synchronous serial communication, each data bit is placed on the communication line from one falling edge of the serial clock to the next. Data is guaranteed valid at the rise of the serial clock. In each character, the serial data bits are transferred in order from LSB (first) to MSB (last). After output of the MSB, the communication line remains in the state of the MSB. In synchronous mode the SCI receives data by synchronizing with the rise of the serial clock.

Communication Format: The data length is fixed at 8 bits. No parity bit or multiprocessor bit can be added.

Clock: An internal clock generated by the on-chip baud rate generator or an external clock input from the SCK pin can be selected by means of the C/$\overline{A}$ bit in SMR and the CKE1 and CKE0 bits in SCR. See table 13.6 for details of SCI clock source selection.

When the SCI operates on an internal clock, it outputs the clock source at the SCK pin. Eight clock pulses are output per transmitted or received character. When the SCI is not transmitting or receiving, the clock signal remains in the high state. If receiving in single-character units is required, an external clock should be selected.

Transmitting and Receiving Data:

- SCI Initialization (Synchronous Mode): Before transmitting or receiving data, clear the TE and RE bits to 0 in SCR, then initialize the SCI as follows.

  When changing the communication mode or format, always clear the TE and RE bits to 0 before following the procedure given below. Clearing TE to 0 sets the TDRE flag to 1 and initializes TSR. Note that clearing RE to 0, however, does not initialize the RDRF, PER, and ORE flags, or RDR, which retain their previous contents.

Figure 13.15 shows a sample flowchart for initializing the SCI.

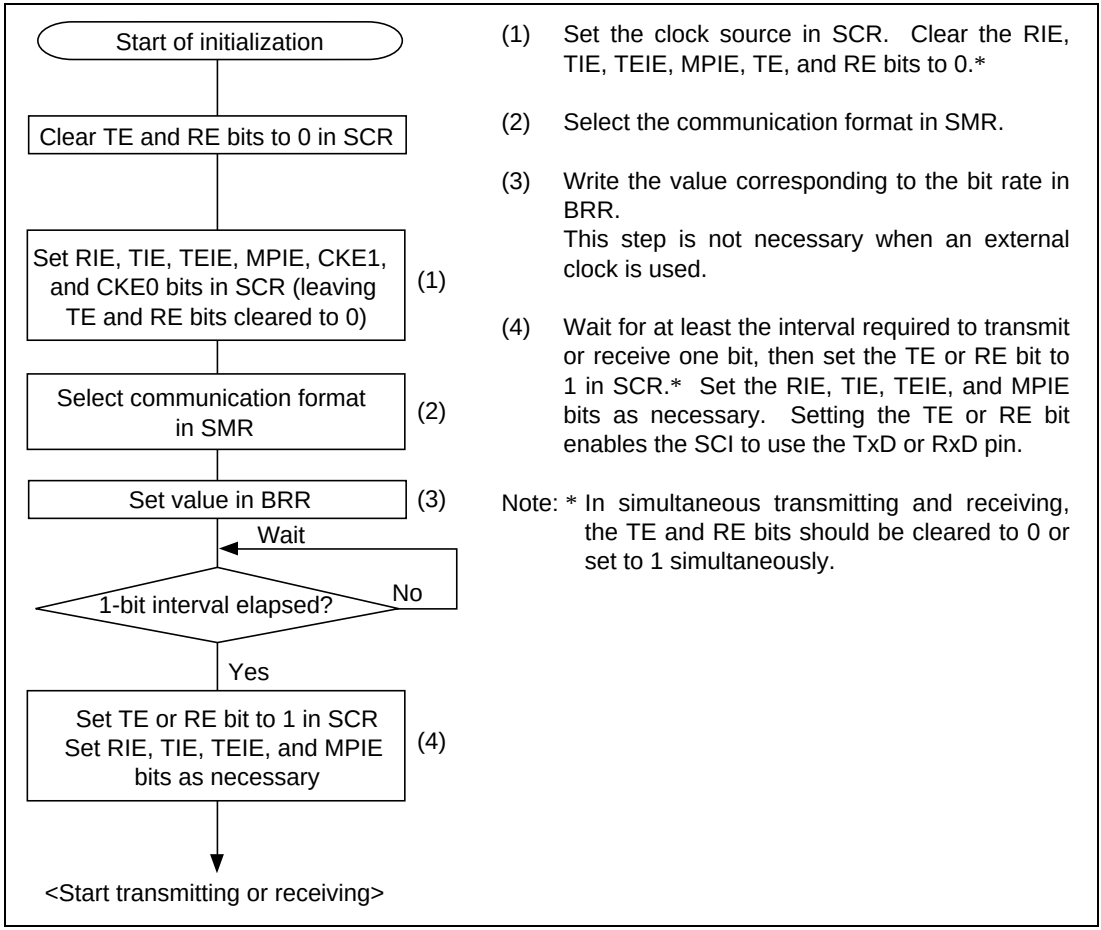
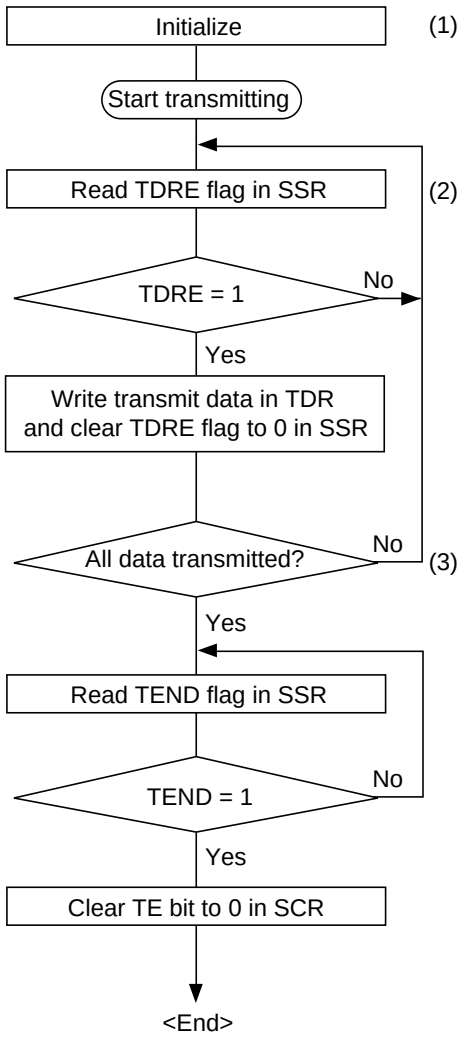


Figure 13.15 Sample Flowchart for SCI Initialization

- Transmitting Serial Data (Synchronous Mode): Figure 13.16 shows a sample flowchart for transmitting serial data and indicates the procedure to follow.



(1) SCI initialization: the transmit data output function of the TxD pin is selected automatically.

(2) SCI status check and transmit data write: read SSR, check that the TDRE flag is 1, then write transmit data in TDR and clear the TDRE flag to 0.

(3) To continue transmitting serial data: after checking that the TDRE flag is 1, indicating that data can be written, write data in TDR, then clear the TDRE flag to 0. When the DMAC is activated by a transmit-data-empty interrupt request (TXI) to write data in TDR, the TDRE flag is checked and cleared automatically.

Figure 13.16 Sample Flowchart for Serial Transmitting

In transmitting serial data, the SCI operates as follows.

- The SCI monitors the TDRE flag in SSR. When the TDRE flag is cleared to 0, the SCI recognizes that TDR contains new data, and loads this data from TDR into TSR.
- After loading the data from TDR to TSR, the SCI sets the TDRE flag to 1 and starts transmitting. If the TIE bit is set to 1 in SCR, the SCI requests a transmit-data-empty interrupt (TXI) at this time.

  If clock output is selected, the SCI outputs eight serial clock pulses. If an external clock source is selected, the SCI outputs data in synchronization with the input clock. Data is output from the TxD pin n order from LSB (bit 0) to MSB (bit 7).
- The SCI checks the TDRE flag when it outputs the MSB (bit 7). If the TDRE flag is 0, the SCI loads data from TDR into TSR and begins serial transmission of the next frame. If the TDRE flag is 1, the SCI sets the TEND flag to 1 in SSR, and after transmitting the MSB (bit 7), holds the TxD pin in the MSB state. If the TEIE bit is set to 1 in SCR, a transmit-end interrupt (TEI) is requested at this time
- After the end of serial transmission, the SCK pin is held in a constant state.

Figure 13.17 shows an example of SCI transmit operation.

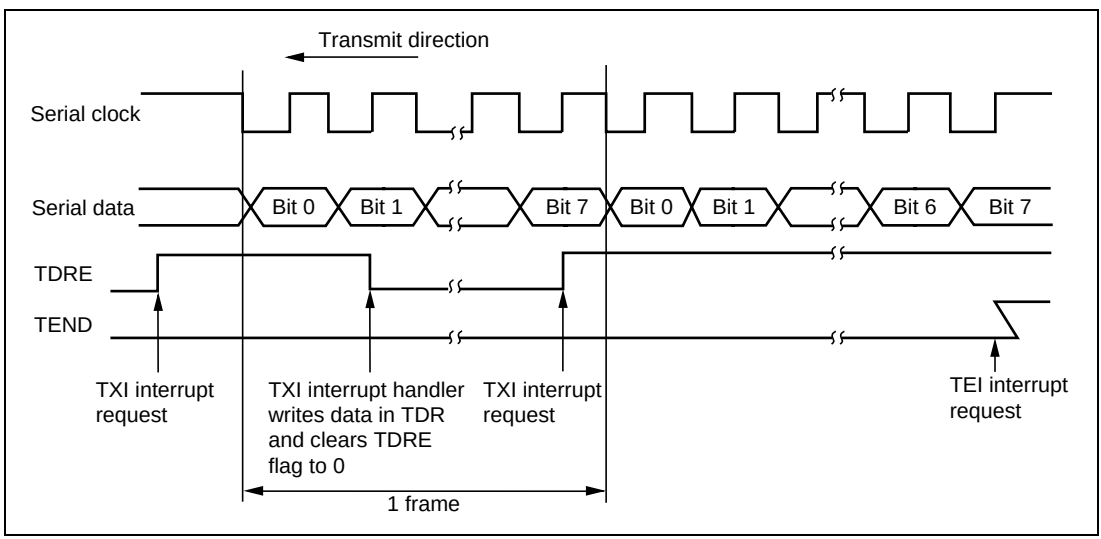
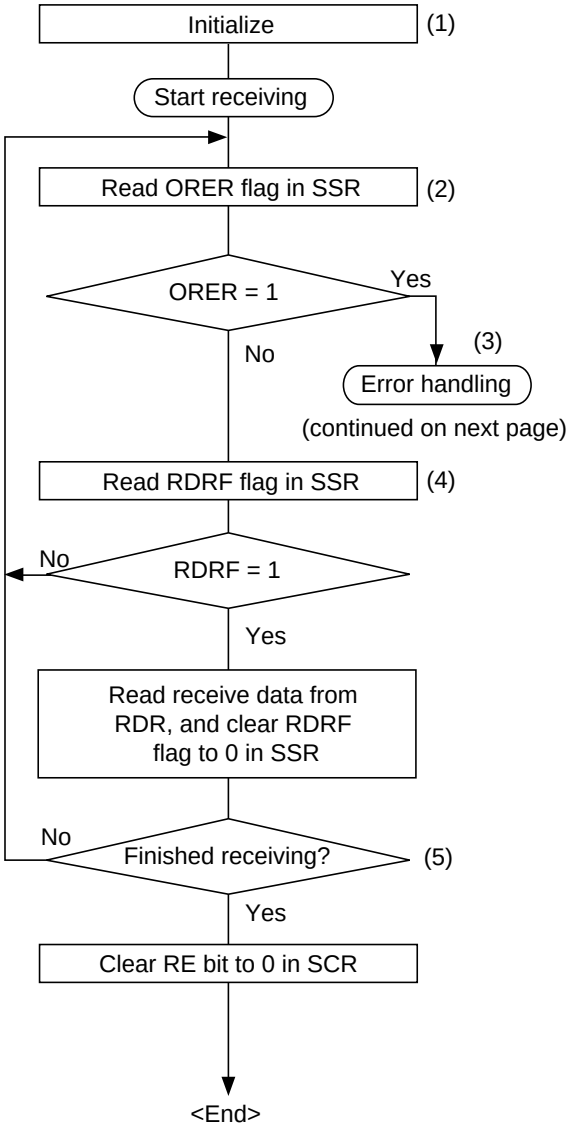


Figure 13.17 Example of SCI Transmit Operation

- Receiving Serial Data (Synchronous Mode): Figure 13.18 shows a sample flowchart for receiving serial data and indicates the procedure to follow. When switching from asynchronous to synchronous mode. make sure that the ORER, PER, and FER flags are cleared to 0. If the FER or PER flag is set to 1 the RDRF flag will not be set and both transmitting and receiving will be disabled.



(1) SCI initialization: the receive data input function of the RxD pin is selected automatically.

(2)(3) Receive error handling: if a receive error occurs, read the ORER flag in SSR, then after executing the necessary error handling, clear the ORER flag to 0. Neither transmitting nor receiving can resume while the ORER flag remains set to 1.

(4) SCI status check and receive data read: read SSR, check that the RDRF flag is set to 1, then read receive data from RDR and clear the RDRF flag to 0. Notification that the RDRF flag has changed from 0 to 1 can also be given by the RXI interrupt.

(5) To continue receiving serial data: check the RDRF flag, read RDR, and clear the RDRF flag to 0 before the MSB (bit 7) of the current frame is received. When the DMAC is activated by a receive-data-full interrupt request (RXI) to read RDR, the RDRF flag is cleared automatically.

Figure 13.18 Sample Flowchart for Serial Receiving (1)

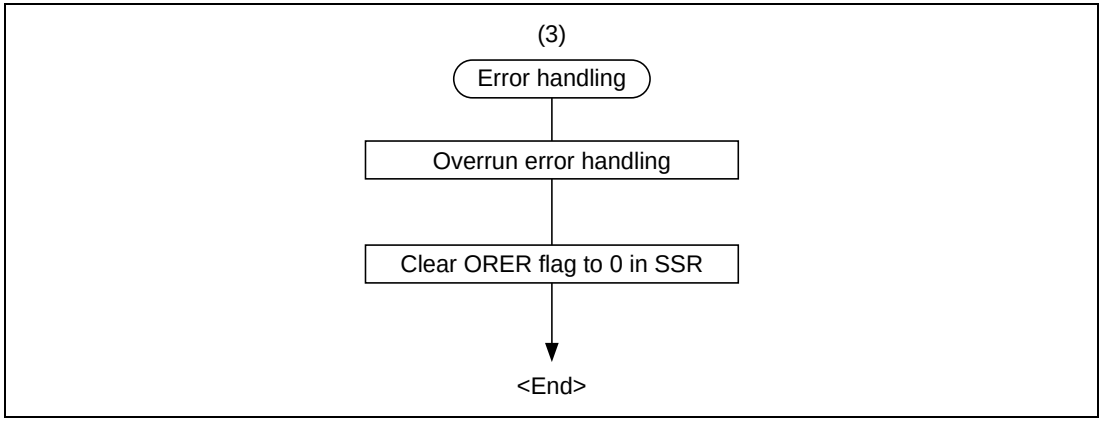


Figure 13.18 Sample Flowchart for Serial Receiving (2)

In receiving, the SCI operates as follows:

- The SCI synchronizes with serial clock input or output and synchronizes internally.
- Receive data is stored in RSR in order from LSB to MSB.

  After receiving the data, the SCI checks that the RDRF flag is 0, so that receive data can be transferred from RSR to RDR. If this check passes, the RDRF flag is set to 1 and the received data is stored in RDR. If the checks fails (receive error), the SCI operates as shown in table 13.11.

  When a receive error has been identified in the error check, subsequent transmit and receive operations are disabled.
- When the RDRF flag is set to 1, if the RIE bit is set to 1 in SCR, a receive-data-full interrupt (RXI) is requested. If the ORER flag is set to 1 and the RIE bit in SCR is also set to 1, a receive-error interrupt (ERI) is requested.

Figure 13.19 shows an example of SCI receive operation.

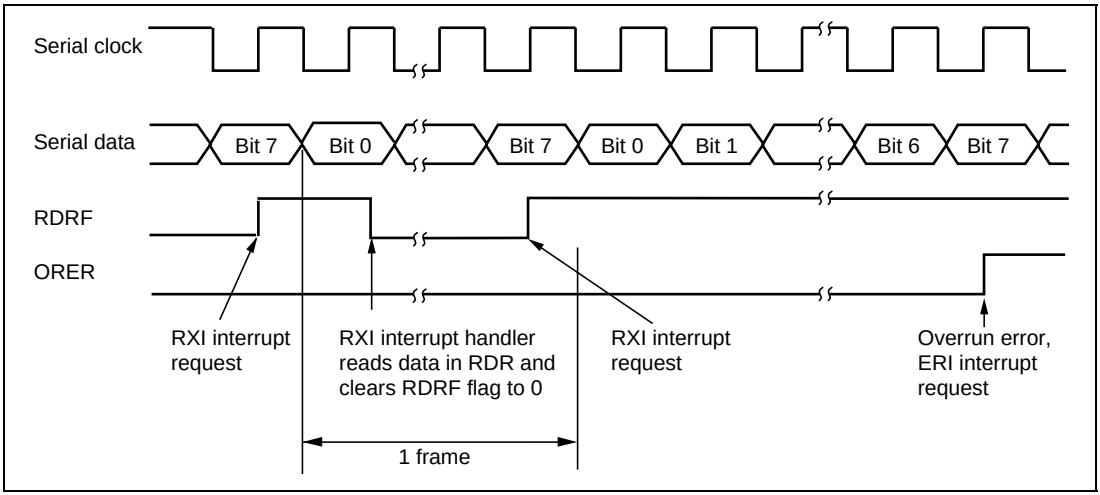
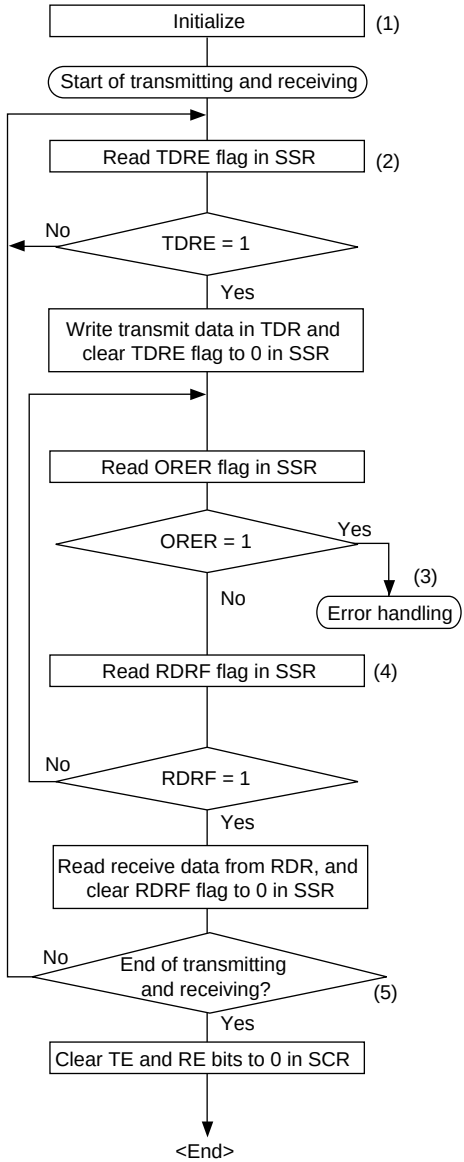


Figure 13.19 Example of SCI Receive Operation

- Transmitting and Receiving Data Simultaneously (Synchronous Mode): Figure 13.20 shows a sample flowchart for transmitting and receiving serial data simultaneously and indicates the procedure to follow.



(1) SCI initialization: the transmit data output function of the TxD pin and the read data input function of the RxD pin are selected, enabling simultaneous transmitting and receiving.

(2) SCI status check and transmit data write: read SSR, check that the TDRE flag is 1, then write transmit data in TDR and clear the TDRE flag to 0.
Notification that the TDRE flag has changed from 0 to 1 can also be given by the TXI interrupt.

(3) Receive error handling: if a receive error occurs, read the ORER flag in SSR, then after executing the necessary error handling, clear the ORER flag to 0.
Neither transmitting nor receiving can resume while the ORER flag remains set to 1.

(4) SCI status check and receive data read: read SSR, check that the RDRF flag is 1, then read receive data from RDR and clear the RDRF flag to 0. Notification that the RDRF flag has changed from 0 to 1 can also be given by the RXI interrupt.

(5) To continue transmitting and receiving serial data: check the RDRF flag, read RDR, and clear the RDRF flag to 0 before the MSB (bit 7) of the current frame is received. Also check that the TDRE flag is set to 1, indicating that data can be written, write data in TDR, then clear the TDRE flag to 0 before the MSB (bit 7) of the current frame is transmitted. When the DMAC is activated by a transmit-data-empty interrupt request (TXI) to write data in TDR, the TDRE flag is checked and cleared automatically. When the DMAC is activated by a receive-data-full interrupt request (RXI) to read RDR, the RDRF flag is cleared automatically.

Note: When switching from transmitting or receiving to simultaneous transmitting and receiving, clear both the TE bit and the RE bit to 0, then set both bits to 1 simultaneously.

Figure 13.20 Sample Flowchart for Simultaneous Serial Transmitting and Receiving

13.4 SCI Interrupts

The SCI has four interrupt request sources: the transmit-end interrupt (TEI), receive-error interrupt (ERI), receive-data-full interrupt (RXI), and transmit-data-empty interrupt (TXI). Table 13.12 lists the interrupt sources and indicates their priority. These interrupts can be enabled or disabled by the TIE, RIE, and TEIE bits in SCR. Each interrupt request is sent separately to the interrupt controller.

A TXI interrupt is requested when the TDRE flag is set to 1 in SSR. A TEI interrupt is requested when the TEND flag is set to 1 in SSR. A TXI interrupt request can activate the DMAC to transfer data. Data transfer by the DMAC automatically clears the TDRE flag to 0. A TEI interrupt request cannot activate the DMAC.

An RXI interrupt is requested when the RDRF flag is set to 1 in SSR. An ERI interrupt is requested when the ORER, PER, or FER flag is set to 1 in SSR. An RXI interrupt can activate the DMAC to transfer data. Data transfer by the DMAC automatically clears the RDRF flag to 0. An ERI interrupt request cannot activate the DMAC.

The DMAC can be activated by interrupts from SCI channel 0.

Table 13.12 SCI Interrupt Sources

Interrupt Source	Description	Priority
ERI	Receive error (ORER, FER, or PER)	High
RXI	Receive data register full (RDRF)	↑
TXI	Transmit data register empty (TDRE)	
TEI	Transmit end (TEND)	Low

13.5 Usage Notes

13.5.1 Notes on Use of SCI

Note the following points when using the SCI.

TDR Write and TDRE Flag: The TDRE flag in SSR is a status flag indicating the loading of transmit data from TDR to TSR. The SCI sets the TDRE flag to 1 when it transfers data from TDR to TSR.

Data can be written into TDR regardless of the state of the TDRE flag. If new data is written in TDR when the TDRE flag is 0, the old data stored in TDR will be lost because this data has not yet been transferred to TSR. Before writing transmit data in TDR, be sure to check that the TDRE flag is set to 1.

Simultaneous Multiple Receive Errors: Table 13.13 shows the state of the SSR status flags when multiple receive errors occur simultaneously. When an overrun error occurs the RSR contents are not transferred to RDR, so receive data is lost.

Table 13.13 SSR Status Flags and Transfer of Receive Data

SSR Status Flags				Receive Data Transfer	
RDRF	**ORER**	**FER**	**PER**	**RSR → RDR**	**Receive Errors**
1	1	0	0	×	Overrun error
0	0	1	0	○	Framing error
0	0	0	1	○	Parity error
1	1	1	0	×	Overrun error + framing error
1	1	0	1	×	Overrun error + parity error
0	0	1	1	○	Framing error + parity error
1	1	1	1	×	Overrun error + framing error + parity error

Notes: ○: Receive data is transferred from RSR to RDR.
×: Receive data is not transferred from RSR to RDR.

Break Detection and Processing: Break signals can be detected by reading the RxD pin directly when a framing error (FER) is detected. In the break state the input from the RxD pin consists of all 0s, so the FER flag is set and the parity error flag (PER) may also be set. In the break state the SCI receiver continues to operate, so if the FER flag is cleared to 0 it will be set to 1 again.

Sending a Break Signal: The input/output condition and level of the TxD pin are determined by DR and DDR bits. This feature can be used to send a break signal.

After the serial transmitter is initialized, the DR value substitutes for the mark state until the TE bit is set to 1 (the TxD pin function is not selected until the TE bit is set to 1). The DDR and DR bits should therefore be set to 1 beforehand.

To send a break signal during serial transmission, clear the DR bit to 0 , then clear the TE bit to 0. When the TE bit is cleared to 0 the transmitter is initialized, regardless of its current state, so the TxD pin becomes an input/output outputting the value 0.

Receive Error Flags and Transmitter Operation (Synchronous Mode Only): When a receive error flag (ORER, PER, or FER) is set to 1 the SCI will not start transmitting, even if the TDRE flag is cleared to 0. Be sure to clear the receive error flags to 0 when starting to transmit. Note that clearing the RE bit to 0 does not clear the receive error flags to 0.

Receive Data Sampling Timing in Asynchronous Mode and Receive Margin: In asynchronous mode the SCI operates on a base clock with 16 times the bit rate frequency. In receiving, the SCI synchronizes internally with the fall of the start bit, which it samples on the base clock. Receive data is latched at the rising edge of the eighth base clock pulse. See figure 13.21.

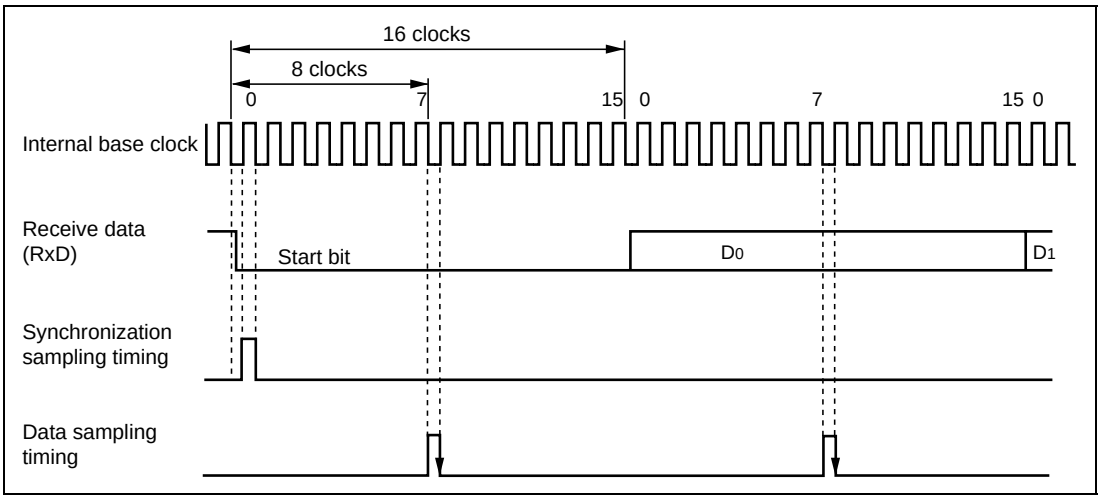


Figure 13.21 Receive Data Sampling Timing in Asynchronous Mode

The receive margin in asynchronous mode can therefore be expressed as shown in equation (1).

$$M = \left| (0.5 - \frac{1}{2N}) - (L - 0.5)\,F - \frac{|D - 0.5|}{N}\,(1 + F) \right| \bullet 100\% \quad \ldots\ldots\ldots (1)$$

M: Receive margin (%)
N: Ratio of clock frequency to bit rate (N = 16)
D: Clock duty cycle (L = 0 to 1.0)
L: Frame length (L = 9 to 12)
F: Absolute deviation of clock frequency

From equation (1), if F = 0 and D = 0.5, the receive margin is 46.875%, as given by equation (2).

D = 0.5, F = 0

$$M = (0.5 - \frac{1}{2 \bullet 16}) \bullet 100\%$$

$$= 46.875\% \quad \ldots\ldots\ldots (2)$$

This is a theoretical value. A reasonable margin to allow in system designs is 20% to 30%.

Restrictions on Use of DMAC:

- When an external clock source is used for the serial clock, after the DMAC updates TDR, allow an inversion of at least five system clock (ϕ) cycles before input of the serial clock to start transmitting. If the serial clock is input within four states of the TDR update, a malfunction may occur (see figure 13.22) .
- To have the DMAC read RDR, be sure to select the corresponding SCI receive-data-full interrupt (RXI) as the activation source with bits DTS2 to DTS0 in DTCR.

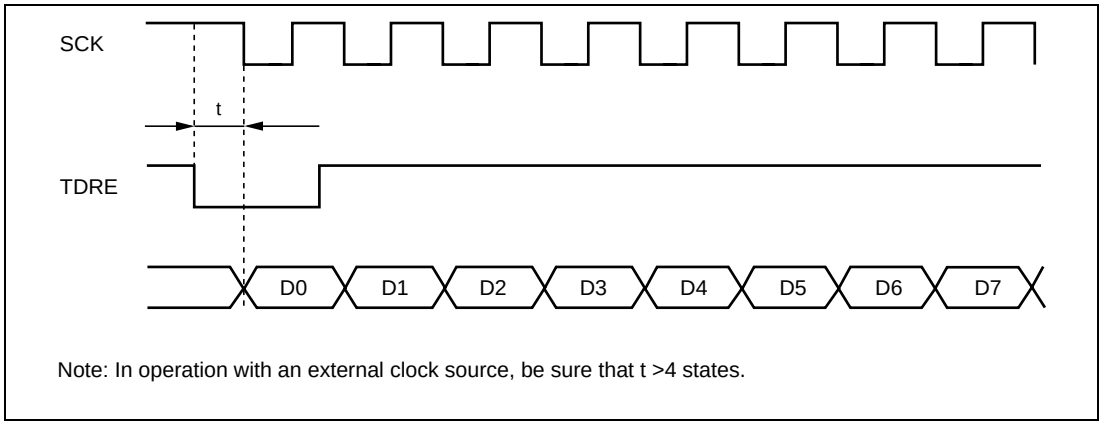


Figure 13.22 Example of Synchronous Transmission Using DMAC

Switching from SCK Pin Function to Port Pin Function:

- Problem in Operation: When switching the SCK pin function to the output port function (high-level output) by making the following settings while DDR = 1, DR = 1, C/$\overline{A}$ = 1, CKE1 = 0, CKE0 = 0, and TE = 1 (synchronous mode), low-level output occurs for one half-cycle.

1. End of serial data transmission
2. TE bit = 0
3. C/$\overline{A}$ bit = 0 ... switchover to port output
4. Occurrence of low-level output (see figure 13.23)

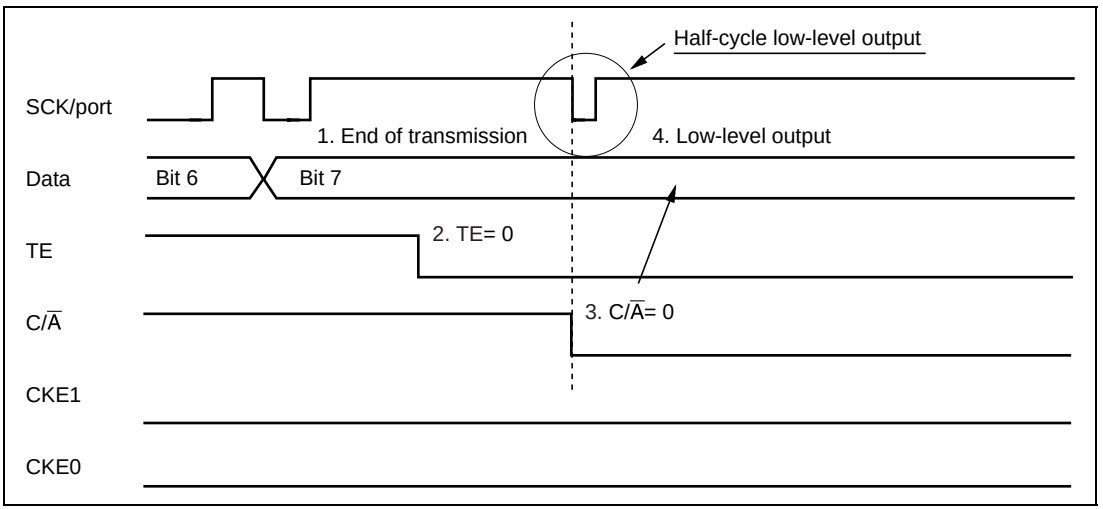


Figure 13.23 Operation when Switching from SCK Pin Function to Port Pin Function

- Sample Procedure for Avoiding Low-Level Output: As this sample procedure temporarily places the SCK pin in the input state, the SCK/port pin should be pulled up beforehand with an external circuit.

  With DDR = 1, DR = 1, C/$\overline{A}$ = 1, CKE1 = 0, CKE0 = 0, and TE = 1, make the following settings in the order shown.

1. End of serial data transmission
2. TE bit = 0
3. CKE1 bit = 1
4. C/$\overline{A}$ bit = 0 ... switchover to port output
5. CKE1 bit = 0

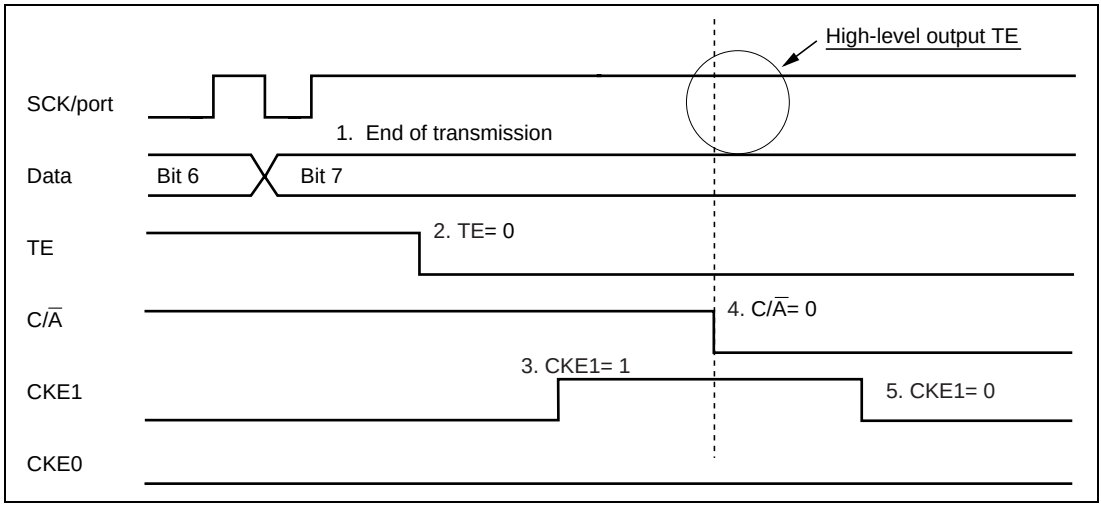


Figure 13.24 Operation when Switching from SCK Pin Function to Port Pin Function (Example of Preventing Low-Level Output)

Section 14 Smart Card Interface

14.1 Overview

An IC card (smart card) interface conforming to the ISO/IEC 7816-3 (Identification Card) standard is supported as an extension of the serial communication interface (SCI) functions.

Switchover between the normal serial communication interface and the smart card interface is controlled by a register setting.

14.1.1 Features

Features of the smart card interface supported by the H8/3069R are listed below.

- Asynchronous communication
  - Data length: 8 bits
  - Parity bit generation and checking
  - Transmission of error signal (parity error) in receive mode
  - Error signal detection and automatic data retransmission in transmit mode
  - Direct convention and inverse convention both supported
- Built-in baud rate generator allows any bit rate to be selected
- Three interrupt sources
  - There are three interrupt sources—transmit-data-empty, receive-data-full, and transmit/receive error—that can issue requests independently.
  - The transmit-data-empty interrupt and receive-data-full interrupt can activate the DMA controller (DMAC) to execute data transfer.

14.1.2 Block Diagram

Figure 14.1 shows a block diagram of the smart card interface.

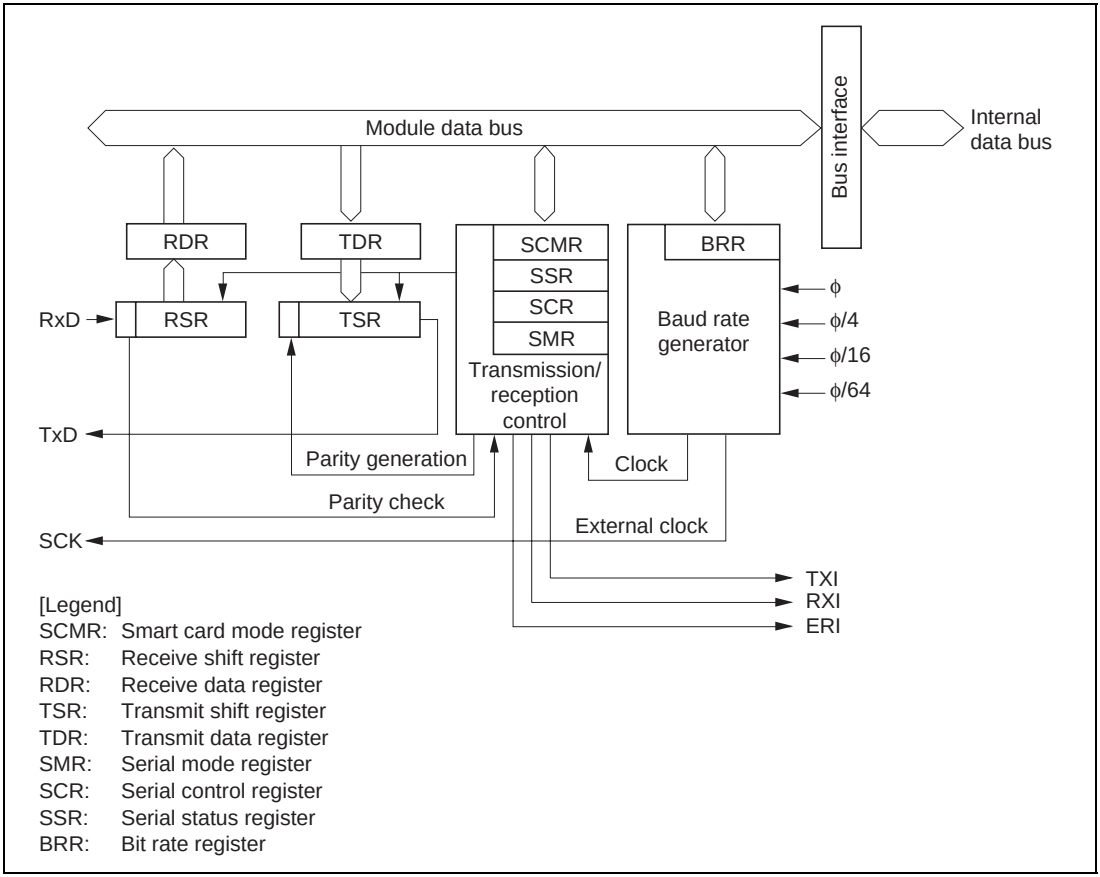


Figure 14.1 Block Diagram of Smart Card Interface

14.1.3 Pin Configuration

Table 14.1 shows the smart card interface pins.

Table 14.1 Smart Card Interface Pins

Pin Name	Abbreviation	I/O	Function
Serial clock pin	SCK	I/O	Clock input/output
Receive data pin	RxD	Input	Receive data input
Transmit data pin	TxD	Output	Transmit data output

14.1.4 Register Configuration

The smart card interface has the internal registers listed in table 14.2. The BRR, TDR, and RDR registers have their normal serial communication interface functions, as described in section 13, Serial Communication Interface.

Table 14.2 Smart Card Interface Registers

Channel	Address*[1]	Name	Abbreviation	R/W	Initial Value
0	H'FFFB0	Serial mode register	SMR	R/W	H'00
	H'FFFB1	Bit rate register	BRR	R/W	H'FF
	H'FFFB2	Serial control register	SCR	R/W	H'00
	H'FFFB3	Transmit data register	TDR	R/W	H'FF
	H'FFFB4	Serial status register	SSR	R/(W)*[2]	H'84
	H'FFFB5	Receive data register	RDR	R	H'00
	H'FFFB6	Smart card mode register	SCMR	R/W	H'F2
1	H'FFFB8	Serial mode register	SMR	R/W	H'00
	H'FFFB9	Bit rate register	BRR	R/W	H'FF
	H'FFFBA	Serial control register	SCR	R/W	H'00
	H'FFFBB	Transmit data register	TDR	R/W	H'FF
	H'FFFBC	Serial status register	SSR	R/(W)*[2]	H'84
	H'FFFBD	Receive data register	RDR	R	H'00
	H'FFFBE	Smart card mode register	SCMR	R/W	H'F2
2	H'FFFC0	Serial mode register	SMR	R/W	H'00
	H'FFFC1	Bit rate register	BRR	R/W	H'FF
	H'FFFC2	Serial control register	SCR	R/W	H'00
	H'FFFC3	Transmit data register	TDR	R/W	H'FF
	H'FFFC4	Serial status register	SSR	R/(W)*[2]	H'84
	H'FFFC5	Receive data register	RDR	R	H'00
	H'FFFC6	Smart card mode register	SCMR	R/W	H'F2

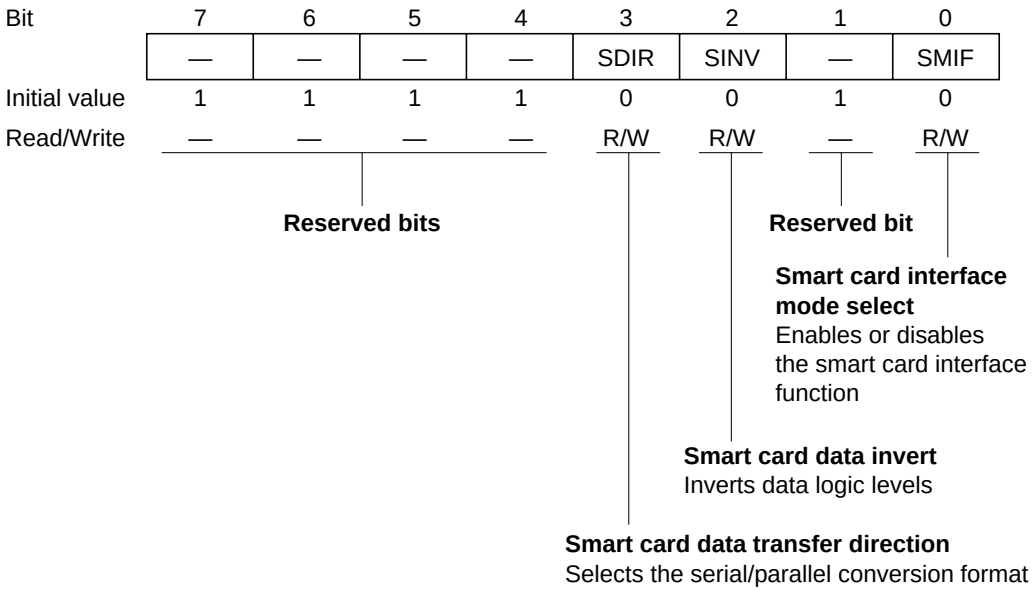
Notes: 1. Lower 20 bits of the address in advanced mode.
2. Only 0 can be written in bits 7 to 3, to clear the flags.

14.2 Register Descriptions

This section describes the new or modified registers and bit functions in the smart card interface.

14.2.1 Smart Card Mode Register (SCMR)

SCMR is an 8-bit readable/writable register that selects smart card interface functions.



SCMR is initialized to H'F2 by a reset and in standby mode.

Bits 7 to 4—Reserved: Read-only bits, always read as 1.

Bit 3—Smart Card Data Transfer Direction (SDIR): Selects the serial/parallel conversion format.*[1]

Bit 3 SDIR	Description	
0	TDR contents are transmitted LSB-first	(Initial value)
	Receive data is stored LSB-first in RDR	
1	TDR contents are transmitted MSB-first	
	Receive data is stored MSB-first in RDR	

Bit 2—Smart Card Data Invert (SINV): Specifies inversion of the data logic level. This function is used in combination with the SDIR bit to communicate with inverse-convention cards.*[2] The SINV bit does not affect the logic level of the parity bit. For parity settings, see section 14.3.4, Register Settings.

Bit 2 SINV	Description	
0	Unmodified TDR contents are transmitted	(Initial value)
	Receive data is stored unmodified in RDR	
1	Inverted TDR contents are transmitted	
	Receive data is inverted before storage in RDR	

Bit 1—Reserved: Read-only bit, always read as 1.

Bit 0—Smart Card Interface Mode Select (SMIF): Enables the smart card interface function.

Bit 0 SMIF	Description	
0	Smart card interface function is disabled	(Initial value)
1	Smart card interface function is enabled	

Notes: 1. The function for switching between LSB-first and MSB-first mode can also be used with the normal serial communication interface. Note that when the communication format data length is set to 7 bits and MSB-first mode is selected for the serial data to be transferred, bit 0 of TDR is not transmitted, and only bits 7 to 1 of the received data are valid.

2. The data logic level inversion function can also be used with the normal serial communication interface. Note that, when inverting the serial data to be transferred, parity transmission and parity checking is based on the number of high-level periods at the serial data I/O pin, and not on the register value.

14.2.2 Serial Status Register (SSR)

The function of SSR bit 4 is modified in smart card interface mode. This change also causes a modification to the setting conditions for bit 2 (TEND).

Bit	7	6	5	4	3	2	1	0
	TDRE	RDRF	ORER	ERS	PER	TEND	MPB	MPBT
Initial value	1	0	0	0	0	1	0	0
Read/Write	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R	R	R/W

Transmit end
Status flag indicating end of transmission

Error signal status (ERS)
Status flag indicating that an error signal has been received

Note: * Only 0 can be written, to clear the flag.

Bits 7 to 5: These bits operate as in normal serial communication. For details see section 13.2.7, Serial Status Register (SSR).

Bit 4—Error Signal Status (ERS): In smart card interface mode, this flag indicates the status of the error signal sent from the receiving device to the transmitting device. The smart card interface does not detection framing errors.

Bit 4 ERS	Description	
0	Indicates normal transmission, with no error signal returned	(Initial value)
	[Clearing conditions]	
	The chip is reset, or enters standby mode or module stop mode	
	Software reads ERS while it is set to 1, then writes 0.	
1	Indicates that the receiving device sent an error signal reporting a parity error	
	[Setting condition]	
	A low error signal was sampled.	

Note: Clearing the TE bit to 0 in SCR does not affect the ERS flag, which retains its previous value.

Bits 3 to 0: These bits operate as in normal serial communication. For details see section 13.2.7, Serial Status Register (SSR). The setting conditions for transmit end (TEND), however, are modified as follows.

Bit 2 TEND	Description
0	Transmission is in progress
	[Clearing conditions]
	Software reads TDRE while it is set to 1, then writes 0 in the TDRE flag.
	The DMAC or DTC writes data in TDR.
1	End of transmission
	[Setting conditions] (Initial value)
	The chip is reset or enters standby mode.
	The TE bit and FER/ERS bit are both cleared to 0 in SCR.
	TDRE is 1 and ERS is 0 at a time 2.5 etu after the last bit of a 1-byte serial character is transmitted (normal transmission).

Note: etu : Elementary Time Unit (time for transfer of 1 bit)

14.2.3 Serial Mode Register (SMR)

The function of SMR bit 7 is modified in smart card interface mode. This change also causes a modification to the function of bits 1 and 0 in the serial control register (SCR).

Bit	7	6	5	4	3	2	1	0
	GM	CHR	PE	O/$\overline{E}$	STOP	MP	CKS1	CKS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Bit 7—GSM Mode (GM): With the normal smart card interface, this bit is cleared to 0. Setting this bit to 1 selects GSM mode, an additional mode for controlling the timing for setting the TEND flag that indicates completion of transmission, and the type of clock output used. The details of the additional clock output control mode are specified by the CKE1 and CKE0 bits in the serial control register (SCR).

Bit 7 GM	Description
0	Normal smart card interface mode operation
	The TEND flag is set 12.5 etu after the beginning of the start bit.
	Clock output on/off control only. (Initial value)
1	GSM mode smart card interface mode operation
	The TEND flag is set 11.0 etu after the beginning of the start bit.
	Clock output on/off and fixed-high/fixed-low control.

Bit 6: Only 0 should be written to this bit.

Bits 5 to 2: These bits operate as in normal serial communication. For details see section 13.2.5, Serial Mode Register (SMR).

Bits 1 and 0: Only 0 should be written to these bits.

14.2.4 Serial Control Register (SCR)

The function of SCR bits 1 and 0 is modified in smart card interface mode

Bit	7	6	5	4	3	2	1	0
	TIE	RIE	TE	RE	MPIE	TEIE	CKE1	CKE0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Bits 7 to 2: These bits operate as in normal serial communication. For details see section 13.2.6, Serial Control Register (SCR).

Bits 1 and 0—Clock Enable 1 and 0 (CKE1, CKE0): These bits select the SCI clock source and enable or disable clock output from the SCK pin. In smart card interface mode, it is possible to specify a fixed high level or fixed low level for the clock output, in addition to the usual switching between enabling and disabling of the clock output.

Bit 7 GM	Bit 1 CKE1	Bit 0 CKE0	Description	
0	0	0	Internal clock/SCK pin is I/O port	(Initial value)
		1	Internal clock/SCK pin is clock output	
1		0	Internal clock/SCK pin is fixed at low output	
		1	Internal clock/SCK pin is clock output	
	1	0	Internal clock/SCK pin is fixed at high output	
		1	Internal clock/SCK pin is clock output	

14.3 Operation

14.3.1 Overview

The main features of the smart card interface are as follows.

- One frame consists of 8-bit data plus a parity bit.

- In transmission, a guard time of at least 2 etu (elementary time units: the time for transfer of one bit) is provided between the end of the parity bit and the start of the next frame.
- If a parity error is detected during reception, a low error signal level is output for a1 etu period 10.5 etu after the start bit.
- If an error signal is detected during transmission, the same data is transmitted automatically after the elapse of 2 etu or longer.
- Only asynchronous communication is supported; there is no synchronous communication function.

14.3.2 Pin Connections

Figure 14.2 shows a pin connection diagram for the smart card interface.

In communication with a smart card, since both transmission and reception are carried out on a single data transmission line, the TxD pin and RxD pin should both be connected to this line. The data transmission line should be pulled up to V_{CC} with a resistor.

When the smart card uses the clock generated on the smart card interface, the SCK pin output is input to the CLK pin of the smart card. If the smart card uses an internal clock, this connection is unnecessary.

The reset signal should be output from one of the H8/3069R's generic ports.

In addition to these pin connections, power and ground connections will normally also be necessary.

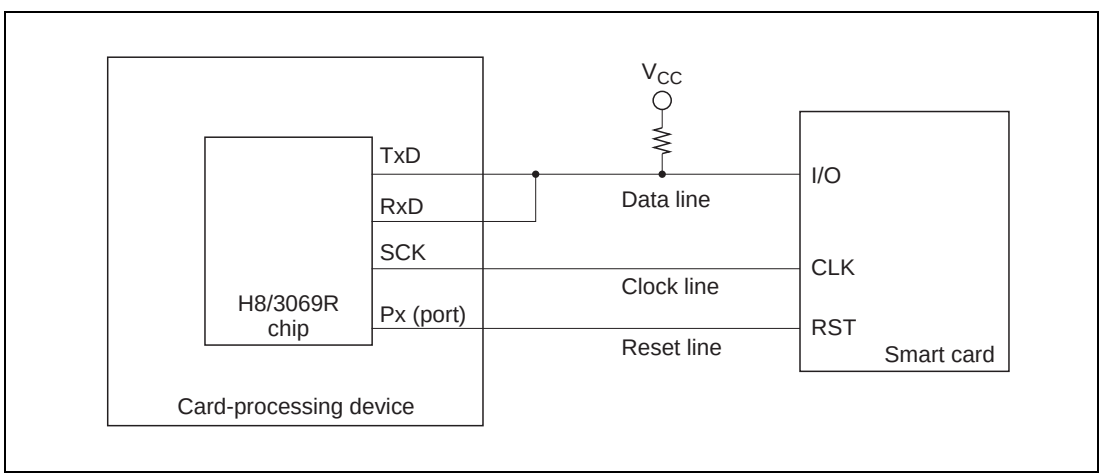


Figure 14.2 Smart Card Interface Connection Diagram

Note: A loop-back test can be performed by setting both RE and TE to 1 without connecting a smart card.

14.3.3 Data Format

Figure 14.3 shows the smart card interface data format. In reception in this mode, a parity check is carried out on each frame, and if an error is detected an error signal is sent back to the transmitting device to request retransmission of the data. In transmission, the error signal is sampled and the same data is retransmitted if the error signal is low.

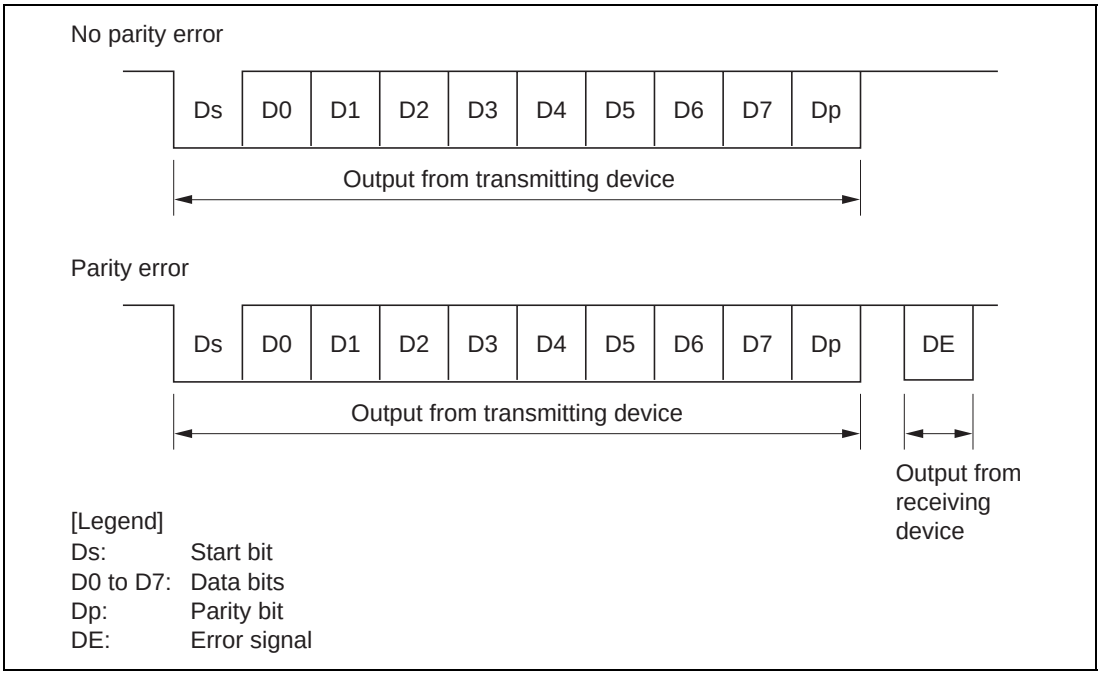


Figure 14.3 Smart Card Interface Data Format

The operating sequence is as follows.

1. When the data line is not in use it is in the high-impedance state, and is fixed high with a pull-up resistor.
2. The transmitting device starts transfer of one frame of data. The data frame starts with a start bit (Ds, low-level), followed by 8 data bits (D0 to D7) and a parity bit (Dp).
3. With the smart card interface, the data line then returns to the high-impedance state. The data line is pulled high with a pull-up resistor.
4. The receiving device carries out a parity check. If there is no parity error and the data is received normally, the receiving device waits for reception of the next data. If a parity error occurs, however, the receiving device outputs an error signal (DE, low-level) to request retransmission of the data. After outputting the error signal for the prescribed length of time, the receiving device places the signal line in the high-impedance state again. The signal line is pulled high again by a pull-up resistor.

5. If the transmitting device does not receive an error signal, it proceeds to transmit the next data frame. If it receives an error signal, however, it returns to step 2 and transmits the same data again.

14.3.4 Register Settings

Table 14.3 shows a bit map of the registers used in the smart card interface. Bits indicated as 0 or 1 must be set to the value shown. The setting of other bits is described in this section.

Table 14.3 Smart Card Interface Register Settings

		Bit							
Register	**Address*[1]**	**Bit 7**	**Bit 6**	**Bit 5**	**Bit 4**	**Bit 3**	**Bit 2**	**Bit 1**	**Bit 0**
SMR	H'FFFB0	GM	0	1	O/$\overline{E}$	1	0	CKS1	CKS0
BRR	H'FFFB1	BRR7	BRR6	BRR5	BRR4	BRR3	BRR2	BRR1	BRR0
SCR	H'FFFB2	TIE	RIE	TE	RE	0	0	CKE1*[2]	CKE0
TDR	H'FFFB3	TDR7	TDR6	TDR5	TDR4	TDR3	TDR2	TDR1	TDR0
SSR	H'FFFB4	TDRE	RDRF	ORER	ERS	PER	TEND	0	0
RDR	H'FFFB5	RDR7	RDR6	RDR5	RDR4	RDR3	RDR2	RDR1	RDR0
SCMR	H'FFFB6	—	—	—	—	SDIR	SINV	—	SMIF

Notes: — Unused bit.
1. Lower 20 bits of the address in advanced mode.
2. When GM is cleared to 0 in SMR, the CKE1 bit must also be cleared to 0.

Serial Mode Register (SMR) Settings: Clear the GM bit to 0 when using the normal smart card interface mode, or set to 1 when using GSM mode. Clear the O/$\overline{E}$ bit to 0 if the smart card is of the direct convention type, or set to 1 if of the inverse convention type.

Bits CKS1 and CKS0 select the clock source of the built-in baud rate generator. See section 14.3.5, Clock.

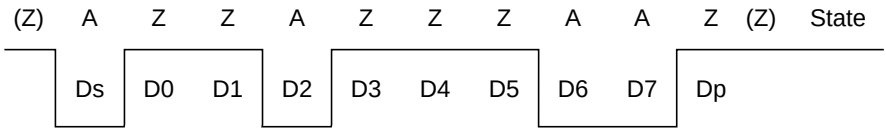
Bit Rate Register (BRR) Settings: BRR is used to set the bit rate. See section 14.3.5, Clock, for the method of calculating the value to be set.

Serial Control Register (SCR) Settings: The TIE, RIE, TE, and RE bits have their normal serial communication functions. See section 13, Serial Communication Interface, for details. The CKE1 and CKE0 bits specify clock output. To disable clock output, clear these bits to 00; to enable clock output, set these bits to 01. Clock output is not performed when the GM bit is set to 1 in SMR. Clock output can also be fixed low or high.

Smart Card Mode Register (SCMR) Settings: Clear both the SDIR bit and SINV bit cleared to 0 if the smart card is of the direct convention type, and set both to 1 if of the inverse convention type. To use the smart card interface, set the SMIF bit to 1.

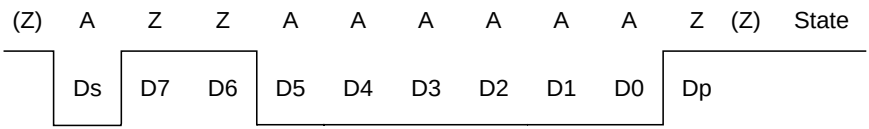
The register settings and examples of starting character waveforms are shown below for two smart cards, one following the direct convention and one the inverse convention.

1. Direct Convention (SDIR = SINV = O/$\overline{E}$ = 0)



With the direct convention type, the logic 1 level corresponds to state Z and the logic 0 level to state A, and transfer is performed in LSB-first order. In the example above, the first character data is H'3B. The parity bit is 1, following the even parity rule designated for smart cards.

2. Indirect Convention (SDIR = SINV = O/$\overline{E}$ = 1)



With the indirect convention type, the logic 1 level corresponds to state A and the logic 0 level to state Z, and transfer is performed in MSB-first order. In the example above, the first character data is H'3F. The parity bit is 0, corresponding to state Z, following the even parity rule designated for smart cards.

In the H8/3069R, inversion specified by the SINV bit applies only to the data bits, D7 to D0. For parity bit inversion, the O/$\overline{E}$ bit in SMR must be set to odd parity mode. This applies to both transmission and reception.

14.3.5 Clock

Only an internal clock generated by the on-chip baud rate generator can be used as the transmit/receive clock for the smart card interface. The bit rate is set with the bit rate register (BRR) and the CKS1 and CKS0 bits in the serial mode register (SMR). The equation for calculating the bit rate is shown below. Table 14.5 shows some sample bit rates.

If clock output is selected with CKE0 set to 1, a clock with a frequency of 372 times the bit rate is output from the SCK pin.

$$B = \frac{\phi}{1488 \bullet 2^{2n-1} \bullet (N + 1)} \bullet 10^6$$

where, N: BRR setting ($0 \leq N \leq 255$)
B: Bit rate (bit/s)
ϕ: Operating frequency (MHz)
n: See table 14.4

Table 14.4 n-Values of CKS1 and CKS0 Settings

n	CKS1	CKS0
0	0	0
1		1
2	1	0
3		1

Note: If the gear function is used to divide the clock frequency, use the divided frequency to calculate the bit rate. The equation above applies directly to 1/1 frequency division.

Table 14.5 Bit Rates (bits/s) for Various BRR Settings (When n = 0)

	ϕ (MHz)							
N	**10.00**	**10.7136**	**13.00**	**14.2848**	**16.00**	**18.00**	**20.00**	**25.00**
0	13440.9	14400.0	17473.1	19200.0	21505.4	24193.5	26881.7	33602.2
1	6720.4	7200.0	8736.6	9600.0	10752.7	12096.8	13440.9	16801.1
2	4480.3	4800.0	5824.4	6400.0	7168.5	8064.5	8960.6	11200.7

Note: Bit rates are rounded off to one decimal place.

The following equation calculates the bit rate register (BRR) setting from the operating frequency and bit rate. N is an integer from 0 to 255, specifying the value with the smaller error.

$$N = \frac{\phi}{1488 \bullet 2^{2n-1} \bullet B} \bullet 10^6 - 1$$

Table 14.6 BRR Settings for Typical Bit Rates (bits/s) (When n = 0)

	ϕ (MHz)							
	10.00	10.7136	13.00	14.2848	16.00	18.00	20.00	25.0
bit/s	N Error	N Error	N Error	N Error	N Error	N Error	N Error	N Error
9600	1 30	1 25	1 8.99	1 0.00	1 12.01	2 15.99	2 6.66	3 12.49

Table 14.7 Maximum Bit Rates for Various Frequencies (Smart Card Interface Mode)

ϕ (MHz)	Maximum Bit Rate (bits/s)	N	n
10.00	13441	0	0
10.7136	14400	0	0
13.00	17473	0	0
14.2848	19200	0	0
16.00	21505	0	0
18.00	24194	0	0
20.00	26882	0	0
25.00	33602	0	0

The bit rate error is given by the following equation:

$$\text{Error (\%)} = \left(\frac{\phi}{1488 \bullet 2^{2n-1} \bullet B \bullet (N + 1)} \bullet 10^6 - 1 \right) \bullet 100$$

14.3.6 Transmitting and Receiving Data

Initialization: Before transmitting or receiving data, the smart card interface must be initialized as described below. Initialization is also necessary when switching from transmit mode to receive mode, or vice versa.

1. Clear the TE and RE bits to 0 in the serial control register (SCR).
2. Clear error flags ERS, PER, and ORER to 0 in the serial status register (SSR).
3. Set the parity bit (O/$\overline{E}$) and baud rate generator select bits (CKS1 and CKS0) in the serial mode register (SMR). Clear the C/$\overline{A}$, CHR, and MP bits to 0, and set the STOP and PE bits to 1.
4. Set the SMIF, SDIR, and SINV bits in the smart card mode register (SCMR).

   When the SMIF bit is set to 1, the TxD pin and RxD pin are both switched from port to SCI pin functions and go to the high-impedance state.
5. Set a value corresponding to the desired bit rate in the bit rate register (BRR).
6. Set the CKE0 bit in SCR. Clear the TIE, RIE, TE, RE, MPIE, TEIE, and CKE1 bits to 0. If the CKE0 bit is set to 1, the clock is output from the SCK pin.
7. Wait at least one bit interval, then set the TIE, RIE, TE, and RE bits in SCR. Do not set the TE bit and RE bit at the same time, except for self-diagnosis.

Transmitting Serial Data: As data transmission in smart card mode involves error signal sampling and retransmission processing, the processing procedure is different from that for the normal SCI. Figure 14.5 shows a sample transmission processing flowchart.

1. Perform smart card interface mode initialization as described in Initialization above.
2. Check that the ERS error flag is cleared to 0 in SSR.
3. Repeat steps 2 and 3 until it can be confirmed that the TEND flag is set to 1 in SSR.
4. Write the transmit data in TDR, clear the TDRE flag to 0, and perform the transmit operation. The TEND flag is cleared to 0.
5. To continue transmitting data, go back to step 2.
6. To end transmission, clear the TE bit to 0.

The above processing may include interrupt handling DMA transfer.

If transmission ends and the TEND flag is set to 1 while the TIE bit is set to 1 and interrupt requests are enabled, a transmit-data-empty interrupt (TXI) will be requested. If an error occurs in transmission and the ERS flag is set to 1 while the RIE bit is set to 1 and interrupt requests are enabled, a transmit/receive-error interrupt (ERI) will be requested.

The timing of TEND flag setting depends on the GM bit in SMR (see figure 14.4).

If the TXI interrupt activates the DMAC, the number of bytes designated in the DMAC can be transmitted automatically, including automatic retransmission.

For details, see Interrupt Operations and Data Transfer by DMAC in this section.

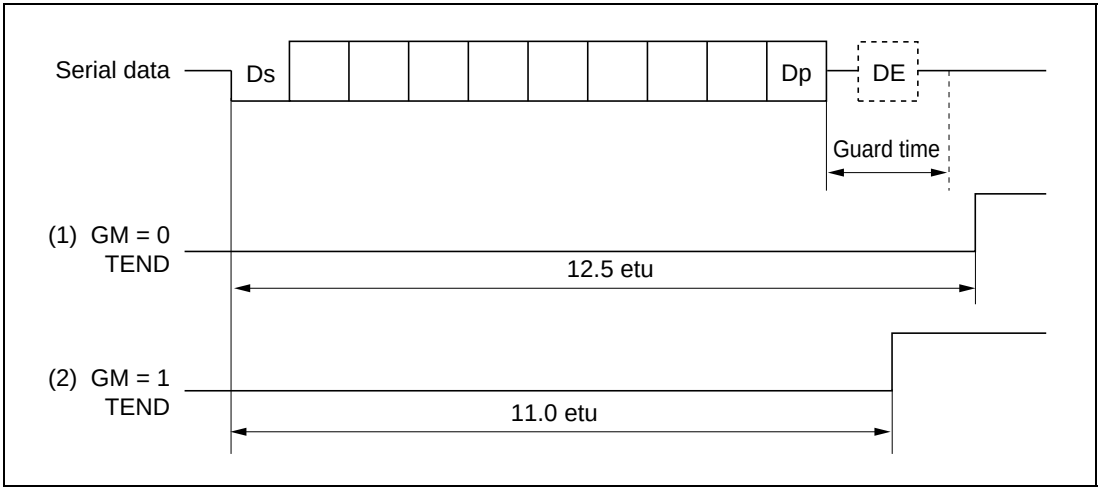


Figure 14.4 Timing of TEND Flag Setting

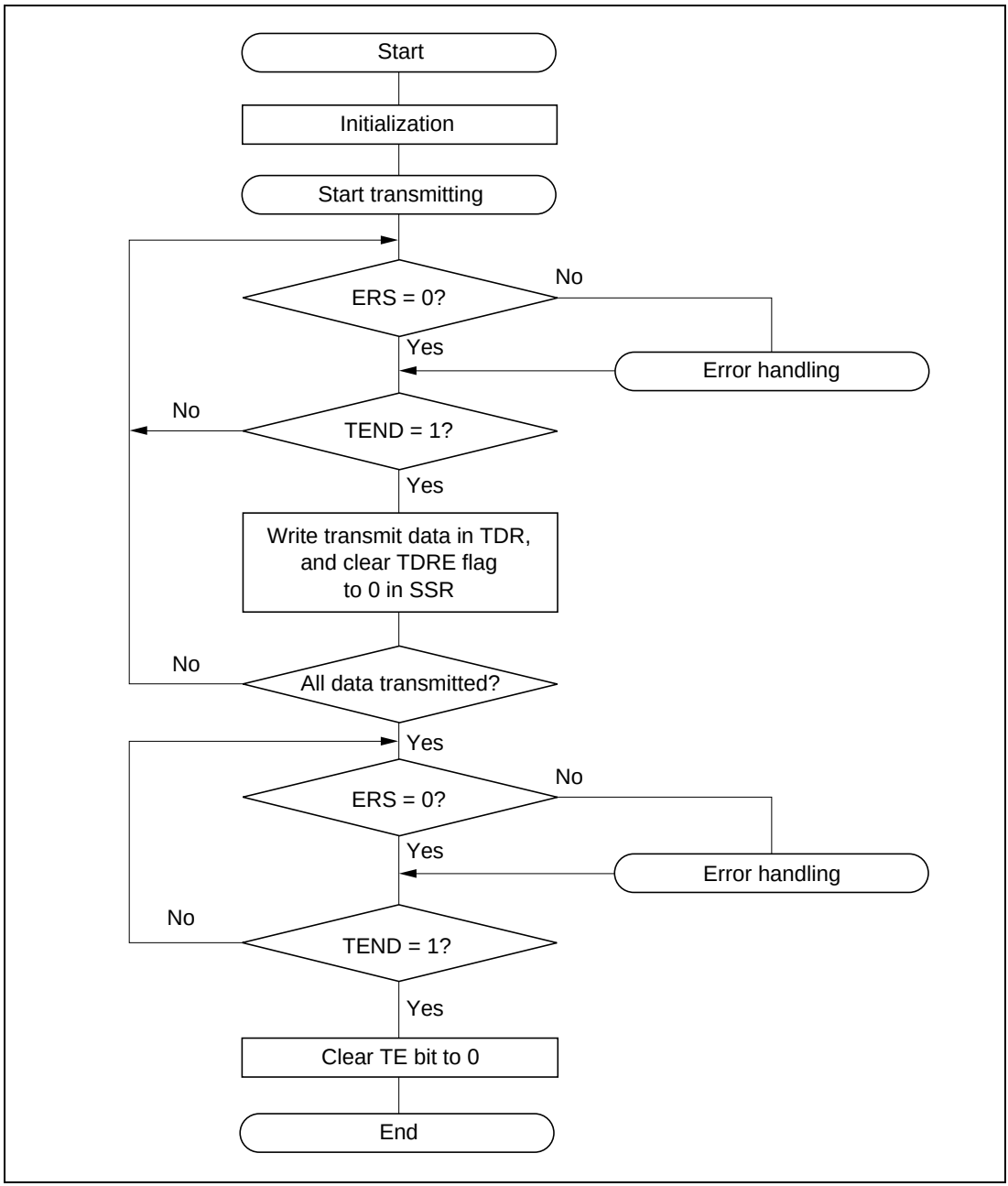


Figure 14.5 Sample Transmission Processing Flowchart

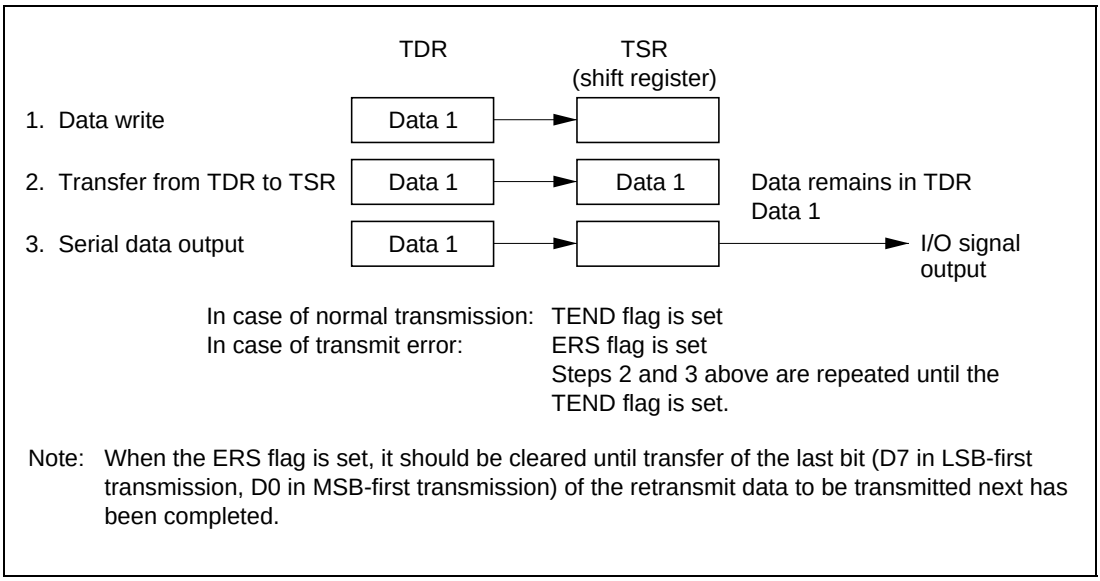


Figure 14.6 Relation Between Transmit Operation and Internal Registers

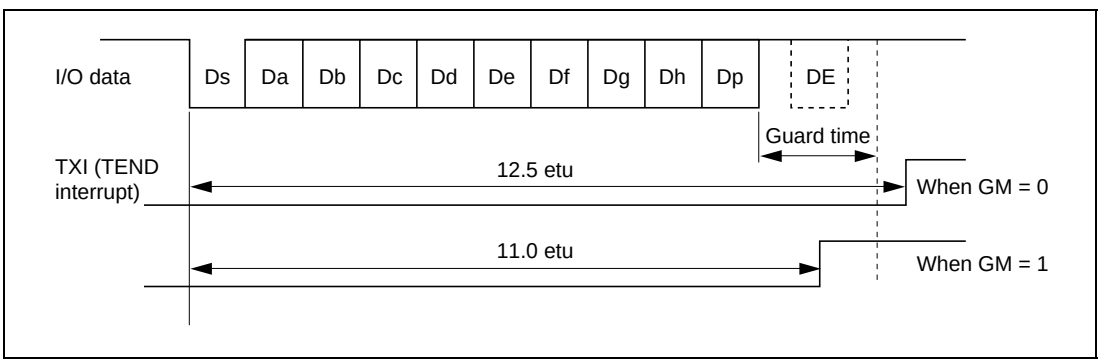


Figure 14.7 Timing of TEND Flag Setting

Receiving Serial Data: Data reception in smart card mode uses the same processing procedure as for the normal SCI. Figure 14.8 shows a sample reception processing flowchart.

1. Perform smart card interface mode initialization as described in Initialization above.
2. Check that the ORER flag and PER flag are cleared to 0 in SSR. If either is set, perform the appropriate receive error handling, then clear both the ORER and the PER flag to 0.
3. Repeat steps 2 and 3 until it can be confirmed that the RDRF flag is set to 1.
4. Read the receive data from RDR.
5. To continue receiving data, clear the RDRF flag to 0 and go back to step 2.
6. To end reception, clear the RE bit to 0.

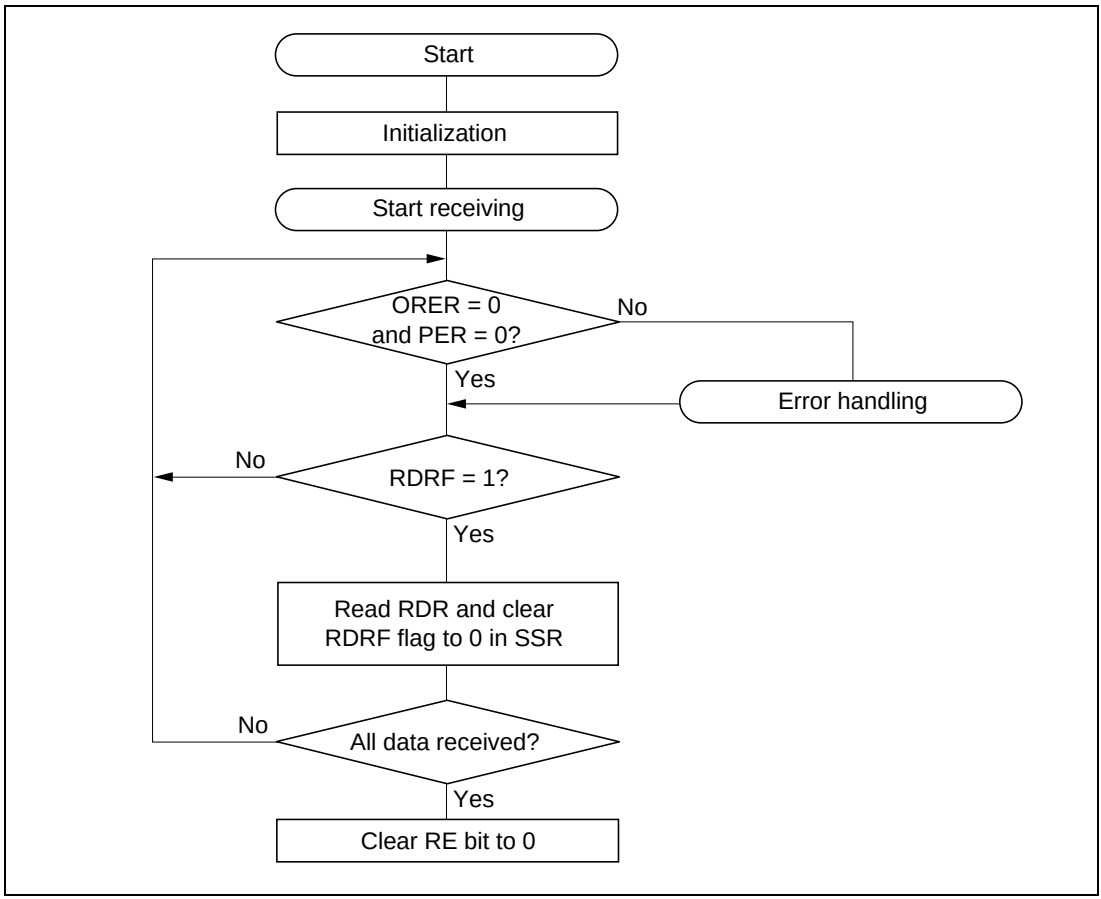


Figure 14.8 Sample Reception Processing Flowchart

The above procedure may include interrupt handling and DMA transfer.

If reception ends and the RDRF flag is set to 1 while the RIE bit is set to 1 and interrupt requests are enabled, a receive-data-full interrupt (RXI) will be requested. If an error occurs in reception and either the ORER flag or the PER flag is set to 1, a transmit/receive-error interrupt (ERI) will be requested.

If the RXI interrupt activates the DMAC, the number of bytes designated in the DMAC will be transferred, skipping receive data in which an error occurred.

For details, see Interrupt Operations and Data Transfer by DMAC in this section.

If a parity error occurs during reception and the PER flag is set to 1, the received data is transferred to RDR, so the erroneous data can be read.

Switching Modes: When switching from receive mode to transmit mode, first confirm that the receive operation has been completed, then start from initialization, clearing RE to 0 and setting TE to 1. The RDRF, PER, or ORER flag can be used to check that the receive operation has been completed.

When switching from transmit mode to receive mode, first confirm that the transmit operation has been completed, then start from initialization, clearing TE to 0 and setting RE to 1. The TEND flag can be used to check that the transmit operation has been completed.

Fixing Clock Output: When the GM bit is set to 1 in SMR, clock output can be fixed by means of the CKE1 and CKE0 bits in SCR. The minimum clock pulse width can be set to the specified width in this case.

Figure 14.9 shows the timing for fixing clock output. In this example, GM = 1, CKE1 = 0, and the CKE0 bit is controlled.

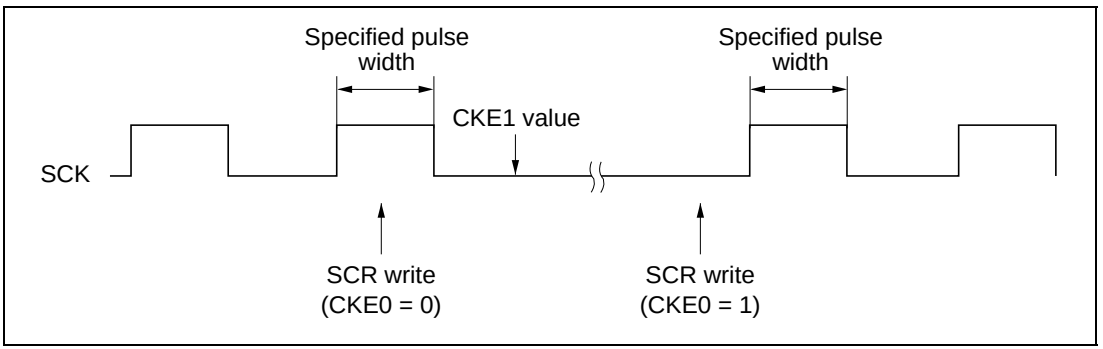


Figure 14.9 Timing for Fixing Cock Output

Interrupt Operations: The smart card interface has three interrupt sources: transmit-data-empty (TXI), transmit/receive-error (ERI), and receive-data-full (RXI). The transmit-end interrupt request (TEI) is not available in smart card mode.

A TXI interrupt is requested when the TEND flag is set to 1 in SSR. An RXI interrupt is requested when the RDRF flag is set to 1 in SSR. An ERI interrupt is requested when the ORER, PER, or ERS flag is set to 1 in SSR. These relationships are shown in table 14.8.

Table 14.8 Smart Card Interface Mode Operating States and Interrupt Sources

Operating State		Flag	Enable Bit	Interrupt Source	DMAC Activation
Transmit Mode	Normal operation	TEND	TIE	TXI	Available
	Error	ERS	RIE	ERI	Not available
Receive Mode	Normal operation	RDRF	RIE	RXI	Available
	Error	PER, ORER	RIE	ERI	Not available

Data Transfer by DMAC: The DMAC can be used to transmit and receive data in smart card mode, as in normal SCI operations. In transmit mode, when the TEND flag is set to 1 in SSR, the TDRE flag is set simultaneously, generating a TXI interrupt. If the TXI request is designated beforehand as a DMAC activation source, the DMAC will be activated by the TXI request and will transfer the next transmit data. This data transfer by the DMAC automatically clears the TDRE and TEND flags to 0. In the event of an error, the SCI automatically retransmits the same data, keeping the TEND flag cleared to 0 so that the DMAC is not activated. The SCI and DMAC will therefore automatically transmit the designated number of bytes, including retransmission when an error occurs. When an error occurs, the ERS flag is not cleared automatically, so the RIE bit should be set to 1 to enable the error to generate an ERI request, and the ERI interrupt handler should clear ERS.

When using the DMAC to transmit or receive, first set up and enable the DMAC, then make SCI settings. DMAC settings are described in section 7, DMA controller.

In receive operations, an RXI interrupt is requested when the RDRF flag is set to 1 in SSR. If the RXI request is designated beforehand as a DMAC activation source, the DMAC will be activated by the RXI request and will transfer the received data. This data transfer by the DMAC automatically clears the RDRF flag to 0. When an error occurs, the RDRF flag is not set and an error flag is set instead. The DMAC is not activated. The ERI interrupt request is directed to the CPU. The ERI interrupt handler should clear the error flags.

Examples of Operation in GSM Mode: When switching between smart card interface mode and software standby mode, use the following procedures to maintain the clock duty cycle.

- Switching from smart card interface mode to software standby mode

1. Set the $P9_4$ data register (DR) and data direction register (DDR) to the values for the fixed output state in software standby mode.
2. Write 0 in the TE and RE bits in the serial control register (SCR) to stop transmit/receive operations. At the same time, set the CKE1 bit to the value for the fixed output state in software standby mode.
3. Write 0 in the CKE0 bit in SCR to stop the clock.
4. Wait for one serial clock cycle. During this period, the duty cycle is preserved and clock output is fixed at the specified level.
5. Write H'00 in the serial mode register (SMR) and smart card mode register (SCMR).
6. Make the transition to the software standby state.

- Returning from software standby mode to smart card interface mode

1. Clear the software standby state.
2. Set the CKE1 bit in SCR to the value for the fixed output state at the start of software standby (the current P94 pin state).
3. Set smart card interface mode and output the clock. Clock signal generation is started with the normal duty cycle.

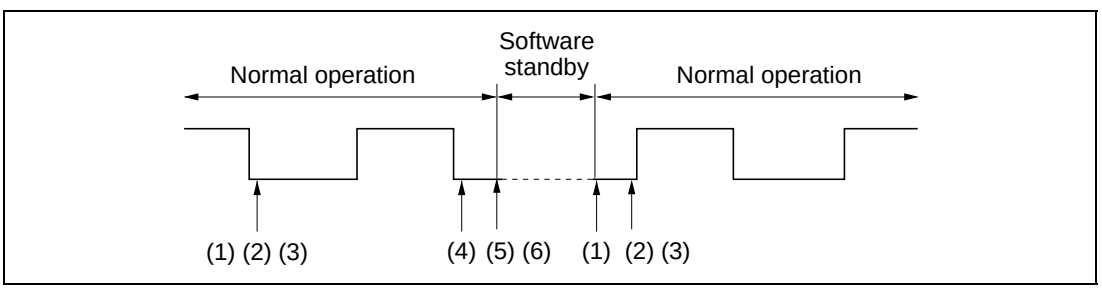


Figure 14.10 Procedure for Stopping and Restarting the Clock

Use the following procedure to secure the clock duty cycle after powering on.

1. The initial state is port input and high impedance. Use pull-up or pull-down resistors to fix the potential.
2. Fix at the output specified by the CKE1 bit in SCR.
3. Set SMR and SCMR, and switch to smart card interface mode operation.
4. Set the CKE0 bit to 1 in SCR to start clock output.

14.4 Usage Notes

The following points should be noted when using the SCI as a smart card interface.

Receive Data Sampling Timing and Receive Margin in Smart Card Interface Mode: In smart card interface mode, the SCI operates on a base clock with a frequency of 372 times the transfer rate. In reception, the SCI synchronizes internally with the fall of the start bit, which it samples on the base clock. Receive data is latched at the rising edge of the 186th base clock pulse. The timing is shown in figure 14.11.

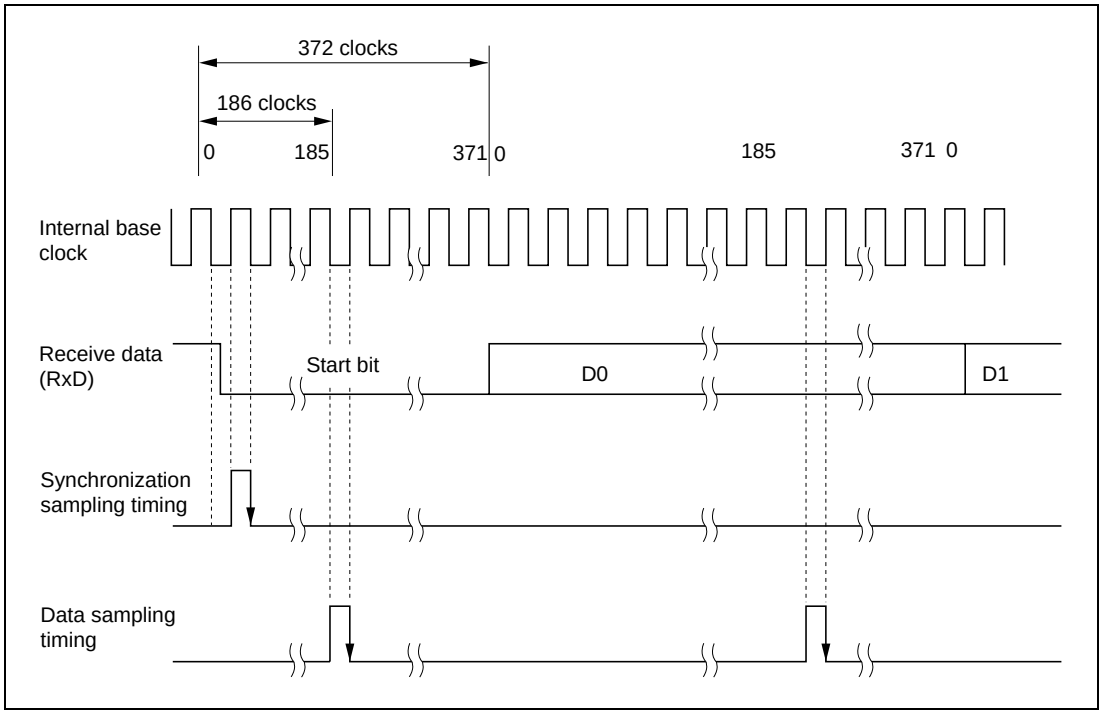


Figure 14.11 Receive Data Sampling Timing in Smart Card Interface Mode

The receive margin can therefore be expressed as follows.

Receive margin in smart card interface mode:

$$M = \left| (0.5 - \frac{1}{2N}) - (L - 0.5)\,F - \frac{|D - 0.5|}{N}\,(1 + F) \right| \bullet 100\%$$

M: Receive margin (%)
N: Ratio of clock frequency to bit rate (N = 372)
D: Clock duty cycle (L = 0 to 1.0)
L: Frame length (L =10)
F: Absolute deviation of clock frequency

From the above equation, if F = 0 and D = 0.5, the receive margin is as follows.

When D = 0.5 and F = 0:

$$M = (0.5 - 1/2 \bullet 372) \bullet 100\%$$
$$= 49.866\%$$

Retransmission: Retransmission is performed by the SCI in receive mode and transmit mode as described below.

- Retransmission when SCI is in Receive Mode
  Figure 14.12 illustrates retransmission when the SCI is in receive mode.

1. If an error is found when the received parity bit is checked, the PER bit is automatically set to 1. If the RIE bit in SCR is set to the enable state, an ERI interrupt is requested. The PER bit should be cleared to 0 in SSR before the next parity bit sampling timing.
2. The RDRF bit in SSR is not set for the frame in which the error has occurred.
3. If no error is found when the received parity bit is checked, the PER bit is not set to 1 in SSR.
4. If no error is found when the received parity bit is checked, the receive operation is assumed to have been completed normally, and the RDRF bit is automatically set to 1 in SSR. If the RIE bit in SCR is set to the enable state, an RXI interrupt is requested. If RXI is enabled as a DMA transfer activation source, the RDR contents can be read automatically. When the DMAC reads the RDR data, the RDRF flag is automatically cleared to 0.
5. When a normal frame is received, the data pin is held in the high-impedance state at the error signal transmission timing.

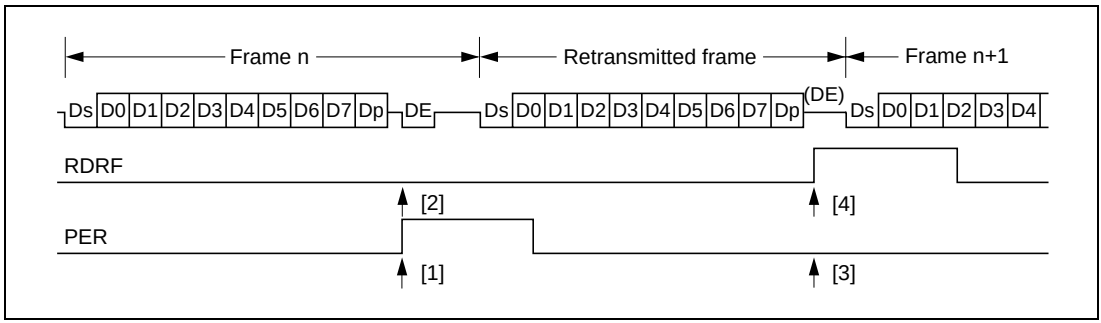


Figure 14.12 Retransmission in SCI Receive Mode

- Retransmission when SCI is in Transmit Mode
  Figure 14.13 illustrates retransmission when the SCI is in transmit mode.

6. If an error signal is sent back from the receiving device after transmission of one frame is completed, the ERS bit is set to 1 in SSR. If the RIE bit in SCR is set to the enable state, an ERI interrupt is requested. The ERS bit should be cleared to 0 in SSR before the next parity bit sampling timing.
7. The TEND bit in SSR is not set for the frame for which the error signal was received.
8. If an error signal is not sent back from the receiving device, the ERS flag is not set in SSR.
9. If an error signal is not sent back from the receiving device, transmission of one frame, including retransmission, is assumed to have been completed, and the TEND bit is set to 1 in SSR. If the TIE bit in SCR is set to the enable state, a TXI interrupt is requested. If TXI is enabled as a DMA transfer activation source, the next data can be written in TDR automatically. When the DMAC writes data in TDR, the TDRE bit is automatically cleared to 0.

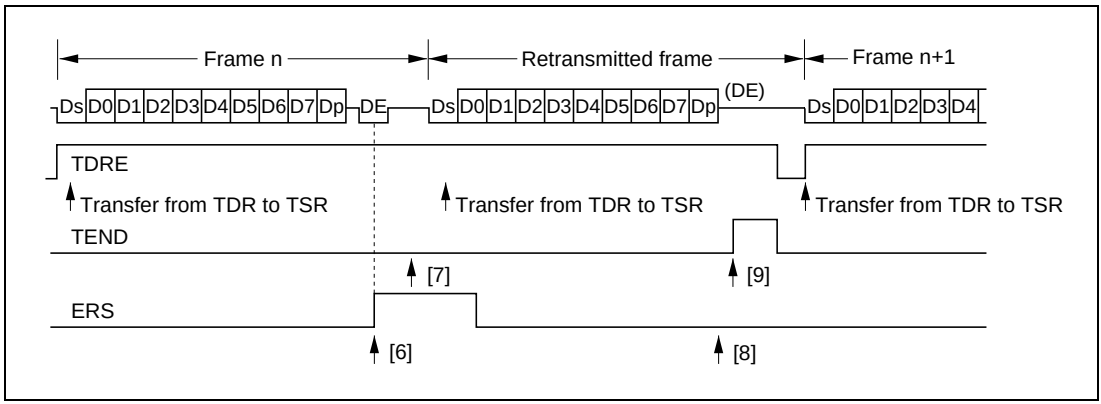


Figure 14.13 Retransmission in SCI Transmit Mode

Support of Block Transfer Mode: The smart card interface of this LSI supports an IC card (smart card) interface corresponding to T=0 (character transfer) in ISO/IEC 7816-3.

Section 15 A/D Converter

15.1 Overview

The H8/3069R includes a 10-bit successive-approximations A/D converter with a selection of up to eight analog input channels.

When the A/D converter is not used, it can be halted independently to conserve power. For details see section 20.6, Module Standby Function.

15.1.1 Features

A/D converter features are listed below.

- 10-bit resolution
- Eight input channels
- Selectable analog conversion voltage range

  The analog voltage conversion range can be programmed by input of an analog reference voltage at the V_{REF} pin.
- High-speed conversion

  Conversion time: maximum 2.8 µs per channel (with 25 MHz system clock)
- Two conversion modes

  Single mode: A/D conversion of one channel

  Scan mode: continuous conversion on one to four channels
- Four 16-bit data registers

  A/D conversion results are transferred for storage into data registers corresponding to the channels.
- Sample-and-hold function
- Three conversion start sources

  The A/D converter can be activated by software, an external trigger, or an 8-bit timer compare match.
- A/D interrupt requested at end of conversion

  At the end of A/D conversion, an A/D end interrupt (ADI) can be requested.
- DMA controller (DMAC) activation

  The DMAC can be activated at the end of A/D conversion.

15.1.2 Block Diagram

Figure 15.1 shows a block diagram of the A/D converter.

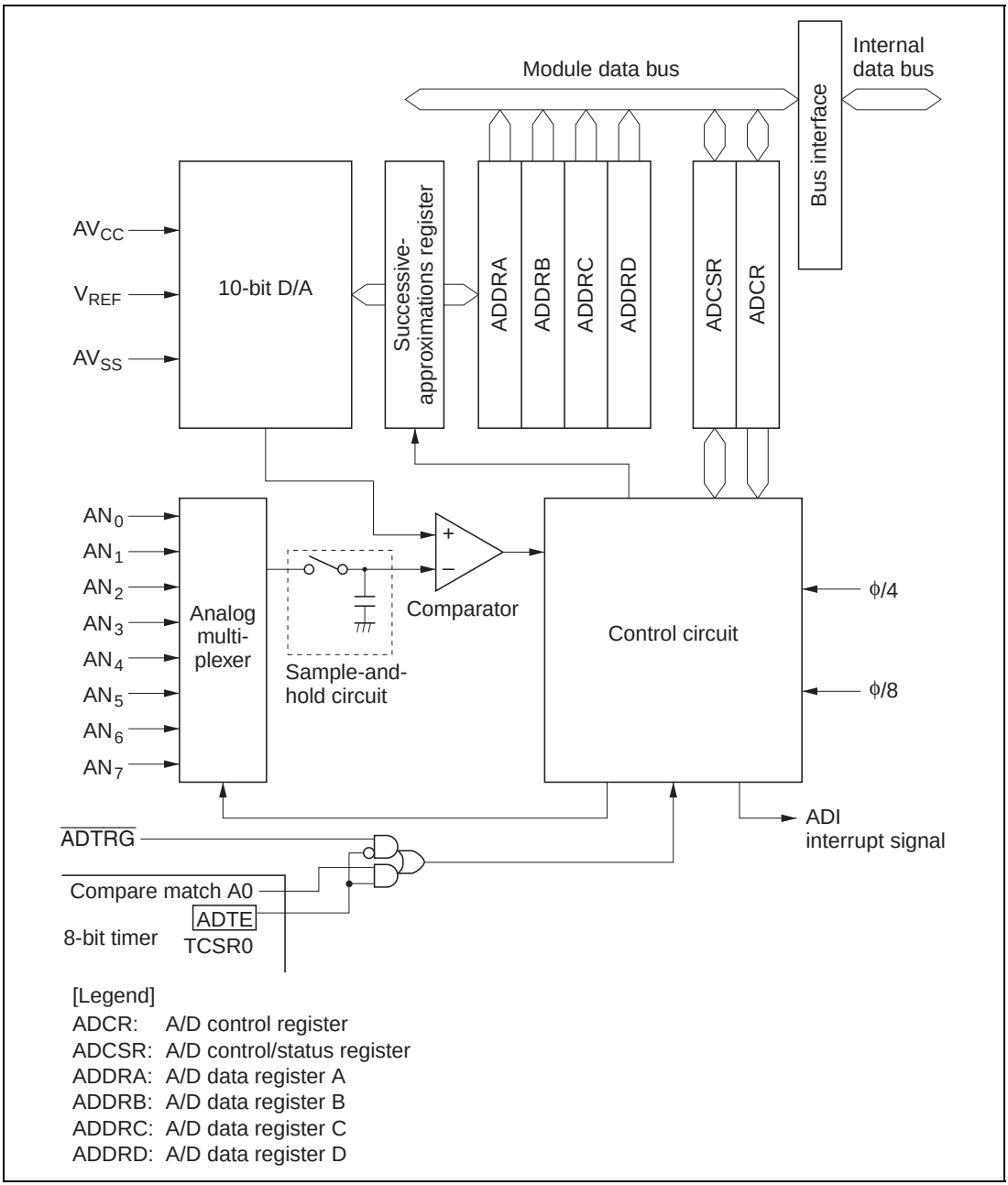


Figure 15.1 A/D Converter Block Diagram

15.1.3 Input Pins

Table 15.1 summarizes the A/D converter's input pins. The eight analog input pins are divided into two groups: group 0 (AN_0 to AN_3), and group 1 (AN_4 to AN_7). AV_{CC} and AV_{SS} are the power supply for the analog circuits in the A/D converter. V_{REF} is the A/D conversion reference voltage.

Table 15.1 A/D Converter Pins

Pin Name	Abbreviation	I/O	Function
Analog power supply pin	AV_{CC}	Input	Analog power supply
Analog ground pin	AV_{SS}	Input	Analog ground and reference voltage
Reference voltage pin	V_{REF}	Input	Analog reference voltage
Analog input pin 0	AN_0	Input	Group 0 analog inputs
Analog input pin 1	AN_1	Input	
Analog input pin 2	AN_2	Input	
Analog input pin 3	AN_3	Input	
Analog input pin 4	AN_4	Input	Group 1 analog inputs
Analog input pin 5	AN_5	Input	
Analog input pin 6	AN_6	Input	
Analog input pin 7	AN_7	Input	
A/D external trigger input pin	$\overline{ADTRG}$	Input	External trigger input for starting A/D conversion

15.1.4 Register Configuration

Table 15.2 summarizes the A/D converter's registers.

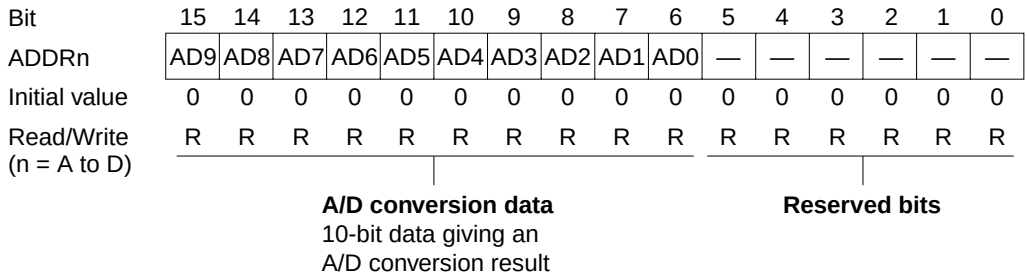
Table 15.2 A/D Converter Registers

Address*[1]	Name	Abbreviation	R/W	Initial Value
H'FFFE0	A/D data register A H	ADDRAH	R	H'00
H'FFFE1	A/D data register A L	ADDRAL	R	H'00
H'FFFE2	A/D data register B H	ADDRBH	R	H'00
H'FFFE3	A/D data register B L	ADDRBL	R	H'00
H'FFFE4	A/D data register C H	ADDRCH	R	H'00
H'FFFE5	A/D data register C L	ADDRCL	R	H'00
H'FFFE6	A/D data register D H	ADDRDH	R	H'00
H'FFFE7	A/D data register D L	ADDRDL	R	H'00
H'FFFE8	A/D control/status register	ADCSR	R/(W)*[2]	H'00
H'FFFE9	A/D control register	ADCR	R/W	H'7E

Notes: 1. Lower 20 bits of the address in advanced mode.
2. Only 0 can be written in bit 7, to clear the flag.

15.2 Register Descriptions

15.2.1 A/D Data Registers A to D (ADDRA to ADDRD)



The four A/D data registers (ADDRA to ADDRD) are 16-bit read-only registers that store the results of A/D conversion.

An A/D conversion produces 10-bit data, which is transferred for storage into the A/D data register corresponding to the selected channel. The upper 8 bits of the result are stored in the upper byte of the A/D data register. The lower 2 bits are stored in the lower byte. Bits 5 to 0 of an A/D data register are reserved bits that are always read as 0. Table 15.3 indicates the pairings of analog input channels and A/D data registers.

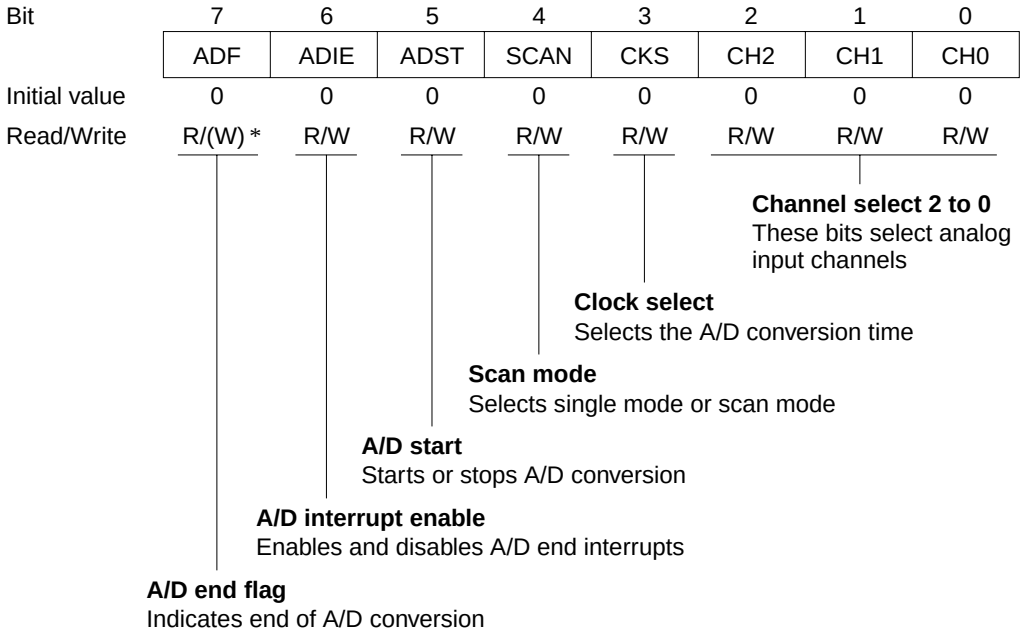
The CPU can always read and write the A/D data registers. The upper byte can be read directly, but the lower byte is read through a temporary register (TEMP). For details see section 15.3, CPU Interface.

The A/D data registers are initialized to H'0000 by a reset and in standby mode.

Table 15.3 Analog Input Channels and A/D Data Registers

Analog Input Channel		
Group 0	**Group 1**	**A/D Data Register**
AN_0	AN_4	ADDRA
AN_1	AN_5	ADDRB
AN_2	AN_6	ADDRC
AN_3	AN_7	ADDRD

15.2.2 A/D Control/Status Register (ADCSR)



Note: * Only 0 can be written, to clear the flag.

ADCSR is an 8-bit readable/writable register that selects the mode and controls the A/D converter. ADCSR is initialized to H'00 by a reset and in standby mode.

Bit 7—A/D End Flag (ADF): Indicates the end of A/D conversion.

Bit 7 ADF	Description	
0	[Clearing condition] Read ADF when ADF =1, then write 0 in ADF. DMAC activated by ADI interrupt.	(Initial value)
1	[Setting conditions] Single mode: A/D conversion ends Scan mode: A/D conversion ends in all selected channels	

Bit 6—A/D Interrupt Enable (ADIE): Enables or disables the interrupt (ADI) requested at the end of A/D conversion.

Bit 6 ADIE	Description	
0	A/D end interrupt request (ADI) is disabled	(Initial value)
1	A/D end interrupt request (ADI) is enabled	

Bit 5—A/D Start (ADST): Starts or stops A/D conversion. The ADST bit remains set to 1 during A/D conversion. It can also be set to 1 by external trigger input at the $\overline{\text{ADTRG}}$ pin, or by an 8-bit timer compare match.

Bit 5 ADST	Description	
0	A/D conversion is stopped	(Initial value)
1	Single mode: A/D conversion starts; ADST is automatically cleared to 0 when conversion ends. Scan mode: A/D conversion starts and continues, cycling among the selected channels, until ADST is cleared to 0 by software, by a reset, or by a transition to standby mode.	

Bit 4—Scan Mode (SCAN): Selects single mode or scan mode. For further information on operation in these modes, see section 15.4, Operation. Clear the ADST bit to 0 before switching the conversion mode.

Bit 4 SCAN	Description	
0	Single mode	(Initial value)
1	Scan mode	

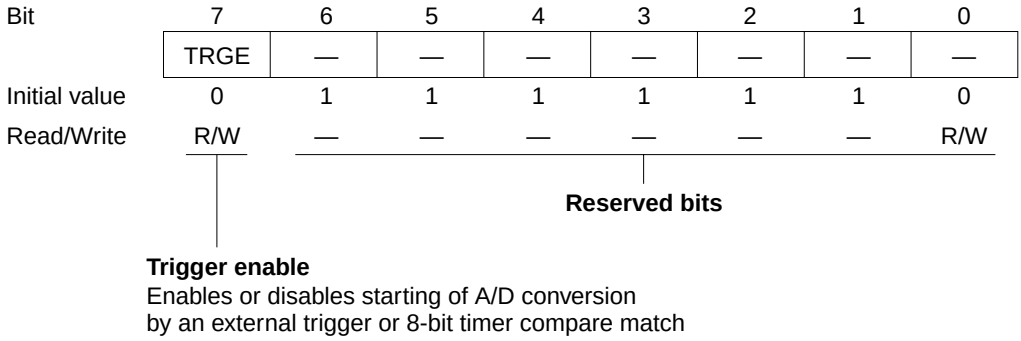
Bit 3—Clock Select (CKS): Selects the A/D conversion time. Clear the ADST bit to 0 before switching the conversion time.

Bit 3 CKS	Description	
0	Conversion time = 134 states (maximum)	(Initial value)
1	Conversion time = 70 states (maximum)	

Bits 2 to 0—Channel Select 2 to 0 (CH2 to CH0): These bits and the SCAN bit select the analog input channels. Clear the ADST bit to 0 before changing the channel selection.

Group Selection	Channel Selection		Description	
CH2	CH1	CH0	Single Mode	Scan Mode
0	0	0	AN_0 (Initial value)	AN_0
		1	AN_1	AN_0, AN_1
	1	0	AN_2	AN_0 to AN_2
		1	AN_3	AN_0 to AN_3
1	0	0	AN_4	AN_4
		1	AN_5	AN_4, AN_5
	1	0	AN_6	AN_4 to AN_6
		1	AN_7	AN_4 to AN_7

15.2.3 A/D Control Register (ADCR)



ADCR is an 8-bit readable/writable register that enables or disables starting of A/D conversion by external trigger input or an 8-bit timer compare match signal. ADCR is initialized to H'7F by a reset and in standby mode.

Bit 7—Trigger Enable (TRGE): Enables or disables starting of A/D conversion by an external trigger or 8-bit timer compare match.

Bit 7 TRGE	Description	
0	Starting of A/D conversion by an external trigger or 8-bit timer compare match is disabled	(Initial value)
1	A/D conversion is started at the falling edge of the external trigger signal ($\overline{\text{ADTRG}}$) or by an 8-bit timer compare match	

External trigger pin and 8-bit timer selection are performed by the 8-bit timer. For details, see section 10, 8-Bit Timers.

Bits 6 to 1—Reserved: These bits cannot be modified and are always read as 1.

Bit 0—Reserved: This bit can be read or written, but must not be set to 1.

15.3 CPU Interface

ADDRA to ADDRD are 16-bit registers, but they are connected to the CPU by an 8-bit data bus. Therefore, although the upper byte can be be accessed directly by the CPU, the lower byte is read through an 8-bit temporary register (TEMP).

An A/D data register is read as follows. When the upper byte is read, the upper-byte value is transferred directly to the CPU and the lower-byte value is transferred into TEMP. Next, when the lower byte is read, the TEMP contents are transferred to the CPU.

When reading an A/D data register, always read the upper byte before the lower byte. It is possible to read only the upper byte, but if only the lower byte is read, incorrect data may be obtained.

Figure 15.2 shows the data flow for access to an A/D data register.

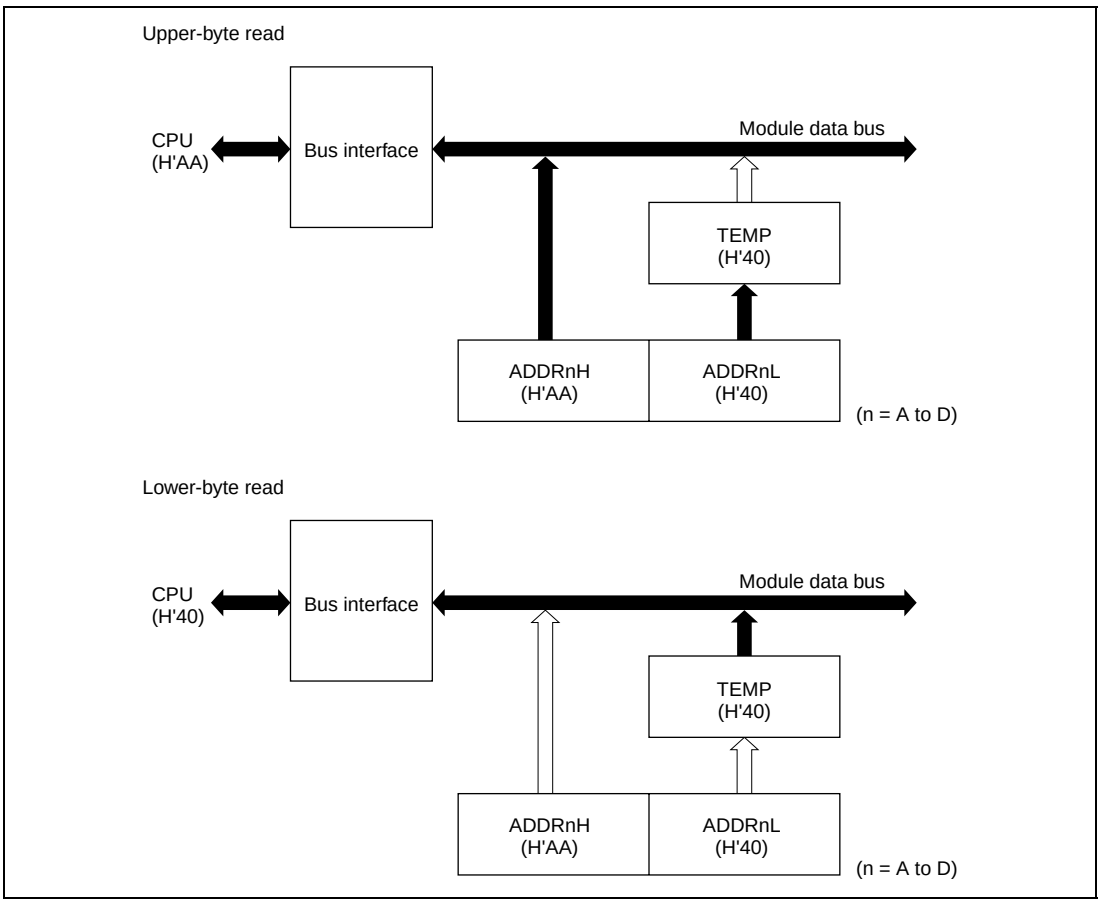


Figure 15.2 A/D Data Register Access Operation (Reading H'AA40)

15.4 Operation

The A/D converter operates by successive approximations with 10-bit resolution. It has two operating modes: single mode and scan mode.

15.4.1 Single Mode (SCAN = 0)

Single mode should be selected when only one A/D conversion on one channel is required. A/D conversion starts when the ADST bit is set to 1 by software, or by external trigger input. The ADST bit remains set to 1 during A/D conversion and is automatically cleared to 0 when conversion ends.

When conversion ends the ADF bit is set to 1. If the ADIE bit is also set to 1, an ADI interrupt is requested at this time. To clear the ADF flag to 0, first read ADCSR, then write 0 in ADF.

When the mode or analog input channel must be switched during analog conversion, to prevent incorrect operation, first clear the ADST bit to 0 in ADCSR to halt A/D conversion. After making the necessary changes, set the ADST bit to 1 to start A/D conversion again. The ADST bit can be set at the same time as the mode or channel is changed.

Typical operations when channel 1 (AN_1) is selected in single mode are described next.

Figure 15.3 shows a timing diagram for this example.

1. Single mode is selected (SCAN = 0), input channel AN_1 is selected (CH2 = CH1 = 0, CH0 = 1), the A/D interrupt is enabled (ADIE = 1), and A/D conversion is started (ADST = 1).
2. When A/D conversion is completed, the result is transferred into ADDRB. At the same time the ADF flag is set to 1, the ADST bit is cleared to 0, and the A/D converter becomes idle.
3. Since ADF = 1 and ADIE = 1, an ADI interrupt is requested.
4. The A/D interrupt handling routine starts.
5. The routine reads ADCSR, then writes 0 in the ADF flag.
6. The routine reads and processes the conversion result (ADDRB).
7. Execution of the A/D interrupt handling routine ends. After that, if the ADST bit is set to 1, A/D conversion starts again and steps 2 to 7 are repeated.

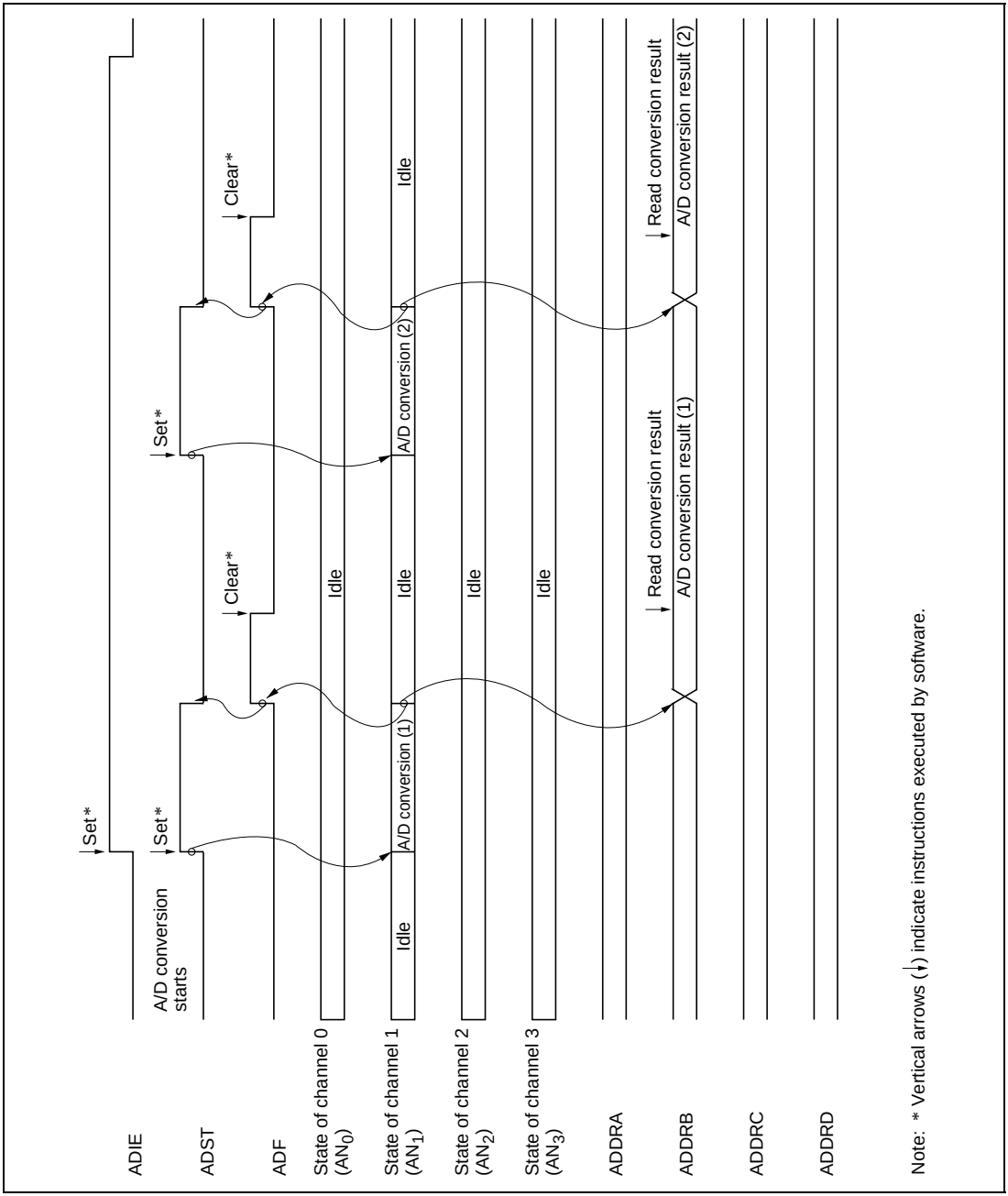


Figure 15.3 Example of A/D Converter Operation (Single Mode, Channel 1 Selected)

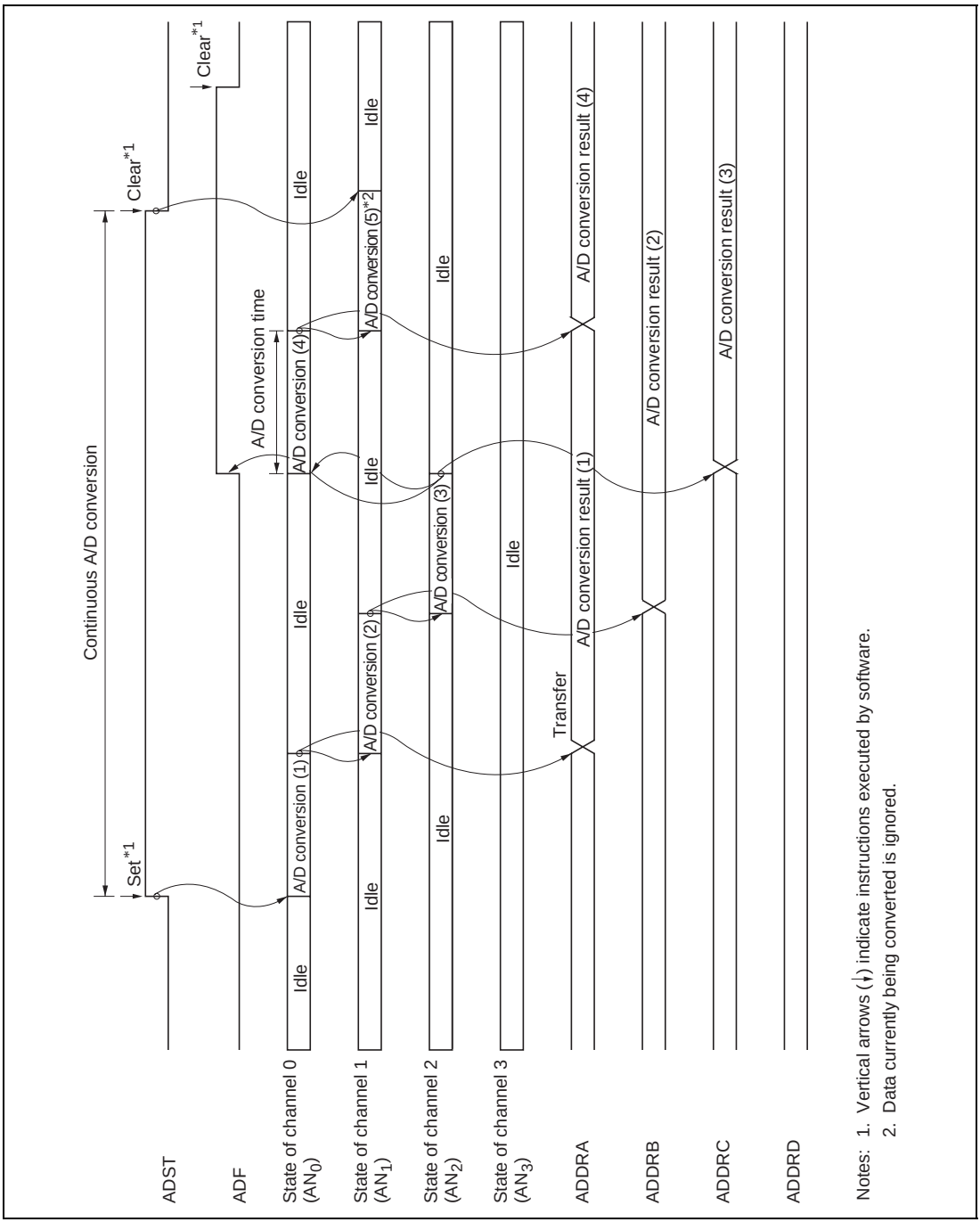
15.4.2 Scan Mode (SCAN = 1)

Scan mode is useful for monitoring analog inputs in a group of one or more channels. When the ADST bit is set to 1 by software or external trigger input, A/D conversion starts on the first channel in the group (AN_0 when CH2 = 0, AN_4 when CH2 = 1). When two or more channels are selected, after conversion of the first channel ends, conversion of the second channel (AN_1 or AN_5) starts immediately. A/D conversion continues cyclically on the selected channels until the ADST bit is cleared to 0. The conversion results are transferred for storage into the A/D data registers corresponding to the channels.

When the mode or analog input channel selection must be changed during analog conversion, to prevent incorrect operation, first clear the ADST bit to 0 in ADCSR to halt A/D conversion. After making the necessary changes, set the ADST bit to 1. A/D conversion will start again from the first channel in the group. The ADST bit can be set at the same time as the mode or channel selection is changed.

Typical operations when three channels in group 0 (AN_0 to AN_2) are selected in scan mode are described next. Figure 15.4 shows a timing diagram for this example.

1. Scan mode is selected (SCAN = 1), scan group 0 is selected (CH2 = 0), analog input channels AN_0 to AN_2 are selected (CH1 = 1, CH0 = 0), and A/D conversion is started (ADST = 1).
2. When A/D conversion of the first channel (AN_0) is completed, the result is transferred into ADDRA. Next, conversion of the second channel (AN_1) starts automatically.
3. Conversion proceeds in the same way through the third channel (AN_2).
4. When conversion of all selected channels (AN_0 to AN_2) is completed, the ADF flag is set to 1 and conversion of the first channel (AN_0) starts again. If the ADIE bit is set to 1, an ADI interrupt is requested at this time.
5. Steps 2 to 4 are repeated as long as the ADST bit remains set to 1. When the ADST bit is cleared to 0, A/D conversion stops. After that, if the ADST bit is set to 1, A/D conversion starts again from the first channel (AN_0).



Notes: 1. Vertical arrows (↓) indicate instructions executed by software.
2. Data currently being converted is ignored.

Figure 15.4 Example of A/D Converter Operation (Scan Mode, Channels AN_0 to AN_2 Selected)

15.4.3 Input Sampling and A/D Conversion Time

The A/D converter has a built-in sample-and-hold circuit. The A/D converter samples the analog input at a time t_D after the ADST bit is set to 1, then starts conversion. Figure 15.5 shows the A/D conversion timing. Table 15.4 indicates the A/D conversion time.

As indicated in figure 15.5, the A/D conversion time includes t_D and the input sampling time. The length of t_D varies depending on the timing of the write access to ADCSR. The total conversion time therefore varies within the ranges indicated in table 15.4.

In scan mode, the values given in table 15.4 apply to the first conversion. In the second and subsequent conversions the conversion time is fixed at 128 states when CKS = 0 or 66 states when CKS = 1.

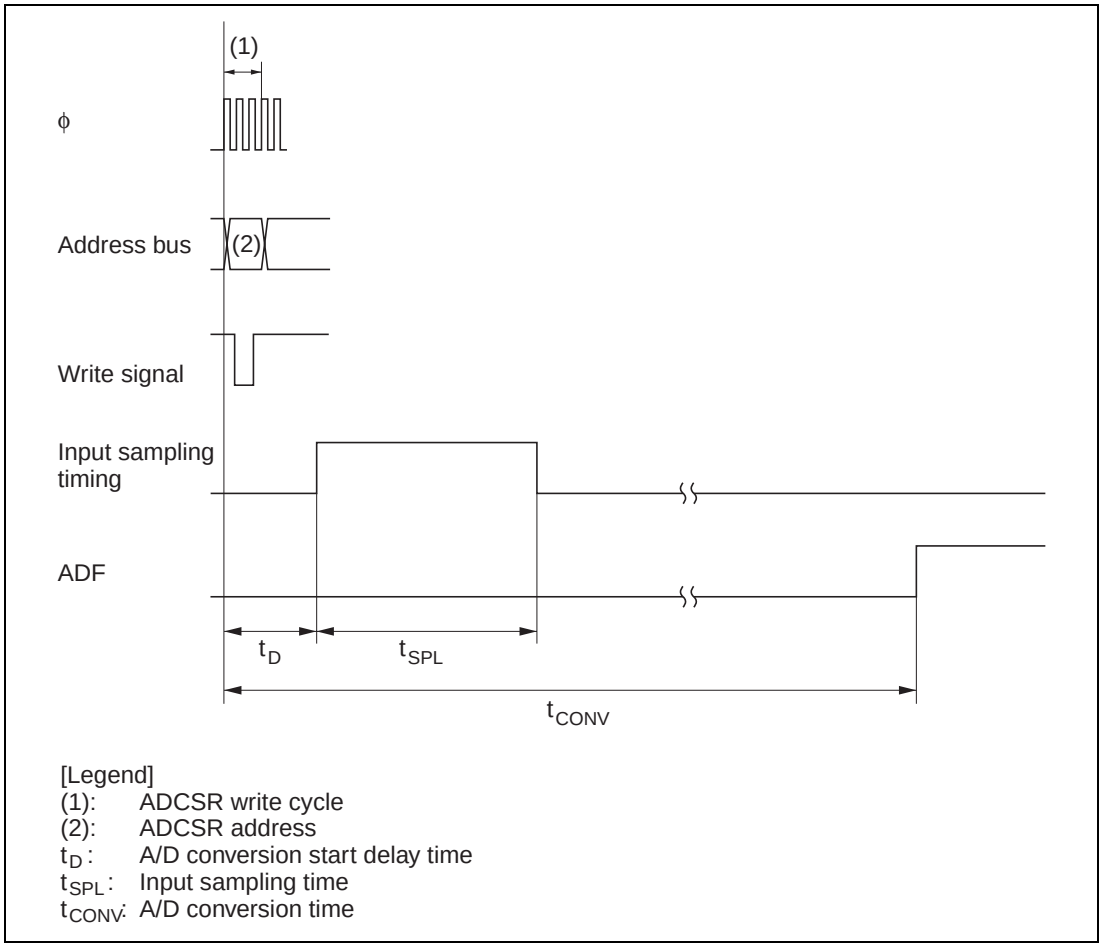


Figure 15.5 A/D Conversion Timing

Table 15.4 A/D Conversion Time (Single Mode)

		CKS = 0			CKS = 1		
	Symbol	**Min**	**Typ**	**Max**	**Min**	**Typ**	**Max**
Synchronization delay	t_D	6	—	9	4	—	5
Input sampling time	t_{SPL}	—	31	—	—	15	—
A/D conversion time	t_{CONV}	131	—	134	69	—	70

Note: Values in the table are numbers of states.

15.4.4 External Trigger Input Timing

A/D conversion can be externally triggered. When the TRGE bit is set to 1 in ADCR and the 8-bit timer's ADTE bit is cleared to 0, external trigger input is enabled at the $\overline{\text{ADTRG}}$ pin. A high-to-low transition at the $\overline{\text{ADTRG}}$ pin sets the ADST bit to 1 in ADCSR, starting A/D conversion. Other operations, in both single and scan modes, are the same as if the ADST bit had been set to 1 by software. Figure 15.6 shows the timing.

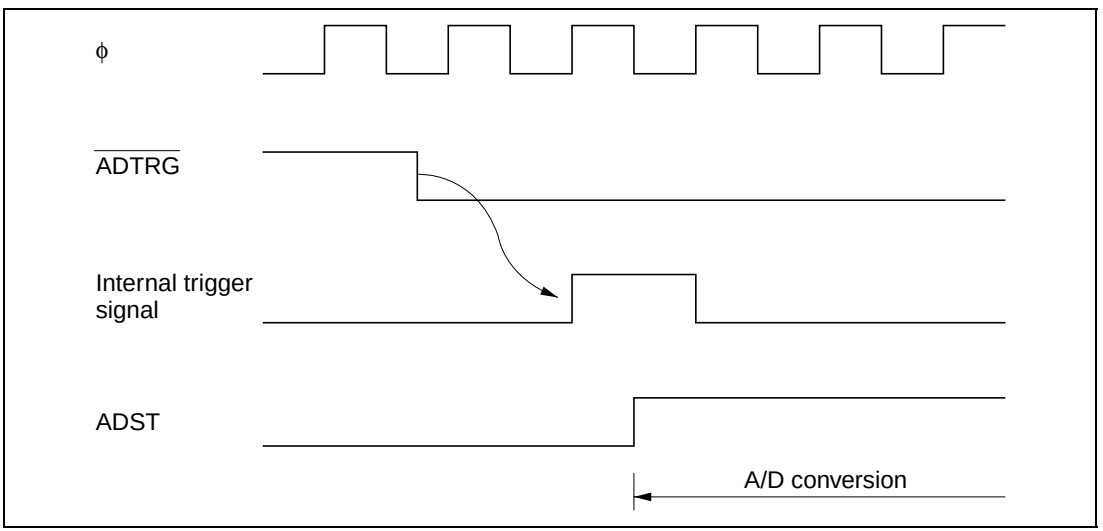


Figure 15.6 External Trigger Input Timing

15.5 Interrupts

The A/D converter generates an interrupt (ADI) at the end of A/D conversion. The ADI interrupt request can be enabled or disabled by the ADIE bit in ADCSR. The ADI interrupt request can be designated as a DMAC activation source. In this case, an interrupt request is not sent to the CPU.

15.6 Usage Notes

When using the A/D converter, note the following points:

1. Analog Input Voltage Range: During A/D conversion, the voltages input to the analog input pins should be in the range $AV_{SS} \leq AN_n \leq V_{REF}$.

2. Relationships of AV_{CC} and AV_{SS} to V_{CC} and V_{SS}: AV_{CC}, AV_{SS}, V_{CC}, and V_{SS} should be related as follows: $AV_{SS} = V_{SS}$. AV_{CC} and AV_{SS} must not be left open, even if the A/D converter is not used.

3. V_{REF} Programming Range: The reference voltage input at the V_{REF} pin should be in the range $V_{REF} \leq AV_{CC}$.

4. Note on Board Design: In board layout, separate the digital circuits from the analog circuits as much as possible. Particularly avoid layouts in which the signal lines of digital circuits cross or closely approach the signal lines of analog circuits. Induction and other effects may cause the analog circuits to operate incorrectly, or may adversely affect the accuracy of A/D conversion. The analog input signals (AN_0 to AN_7), analog reference voltage (V_{REF}), and analog supply voltage (AV_{CC}) must be separated from digital circuits by the analog ground (AV_{SS}). The analog ground (AV_{SS}) should be connected to a stable digital ground (V_{SS}) at one point on the board.

5. Note on Noise: To prevent damage from surges and other abnormal voltages at the analog input pins (AN_0 to AN_7) and analog reference voltage pin (V_{REF}), connect a protection circuit like the one in figure 15.7 between AV_{CC} and AV_{SS}. The bypass capacitors connected to AV_{CC} and V_{REF} and the filter capacitors connected to AN_0 to AN_7 must be connected to AV_{SS}. If filter capacitors like the ones in figure 15.7 are connected, the voltage values input to the analog input pins (AN_0 to AN_7) will be smoothed, which may give rise to error. Error can also occur if A/D conversion is frequently performed in scan mode so that the current that charges and discharges the capacitor in the sample-and-hold circuit of the A/D converter becomes greater than that input to the analog input pins via input impedance Rin. The circuit constants should therefore be selected carefully.

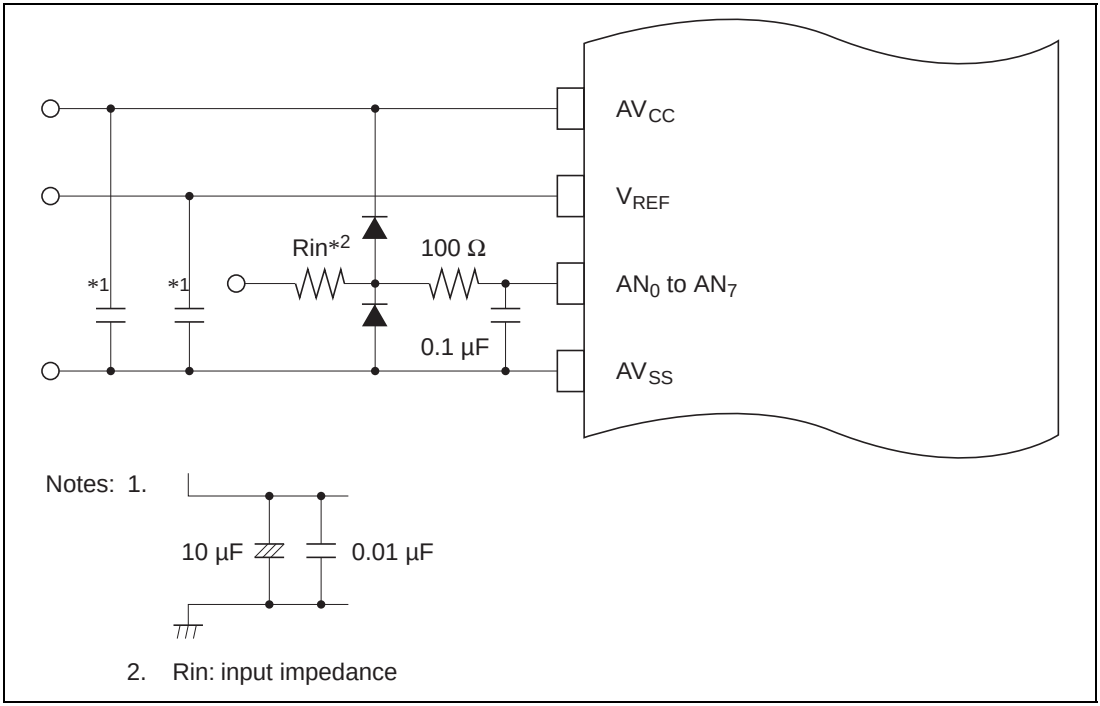


Figure 15.7 Example of Analog Input Protection Circuit

Table 15.5 Analog Input Pin Ratings

Item	min	max	Unit
Analog input capacitance	—	20	pF
Allowable signal-source impedance	—	10*	kΩ

Note: * When conversion time = 134 states, V_{cc} = 4.5 V to 5.5 V, and $\phi \leq 13$ MHz. For details see section 21, Electrical Characteristics.

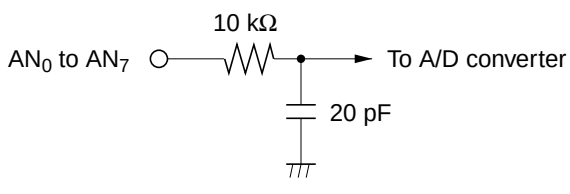


Figure 15.8 Analog Input Pin Equivalent Circuit

Note: Numeric values are approximate, except in table 15.5

6. A/D Conversion Accuracy Definitions: A/D conversion accuracy in the H8/3069R is defined as follows:

- Resolution: .....Digital output code length of A/D converter
- Offset error:.....Deviation from ideal A/D conversion characteristic of analog input voltage required to raise digital output from minimum voltage value 0000000000 to 0000000001 (figure 15.10)
- Full-scale error:.....Deviation from ideal A/D conversion characteristic of analog input voltage required to raise digital output from 1111111110 to 1111111111 (figure 15.10)
- Quantization error:.....Intrinsic error of the A/D converter; 1/2 LSB (figure 15.9)
- Nonlinearity error: .....Deviation from ideal A/D conversion characteristic in range from zero volts to full scale, exclusive of offset error, full-scale error, and quantization error.
- Absolute accuracy:.....Deviation of digital value from analog input value, including offset error, full-scale error, quantization error, and nonlinearity error.

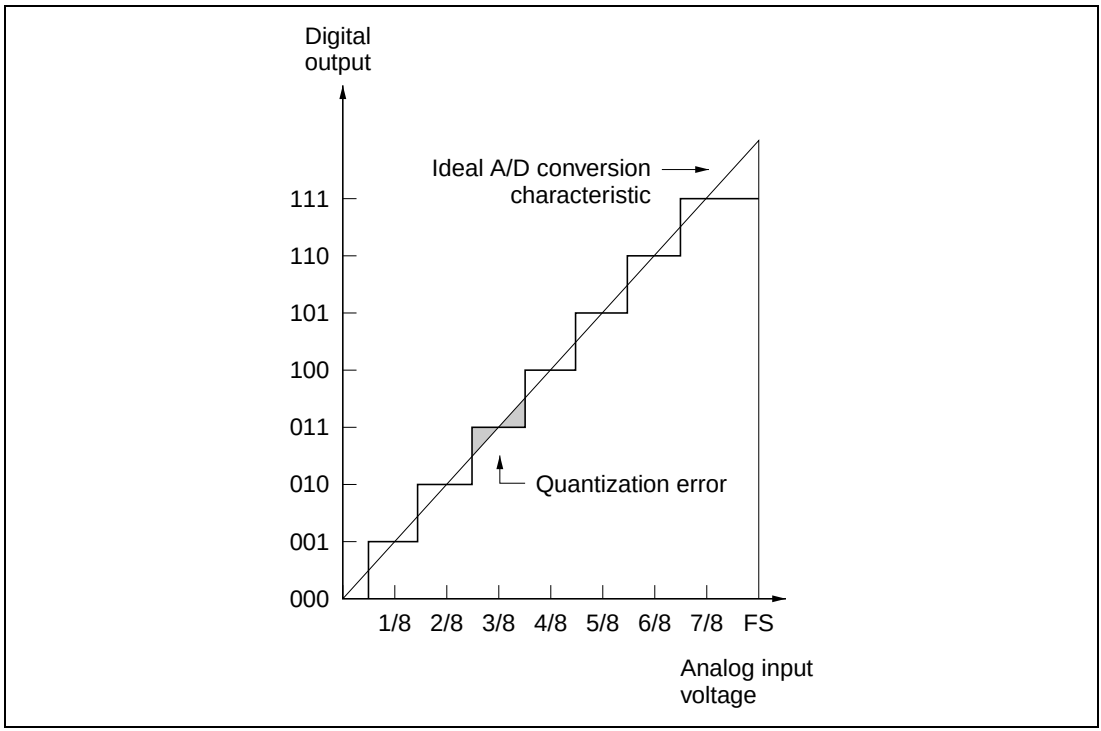


Figure 15.9 A/D Converter Accuracy Definitions (1)

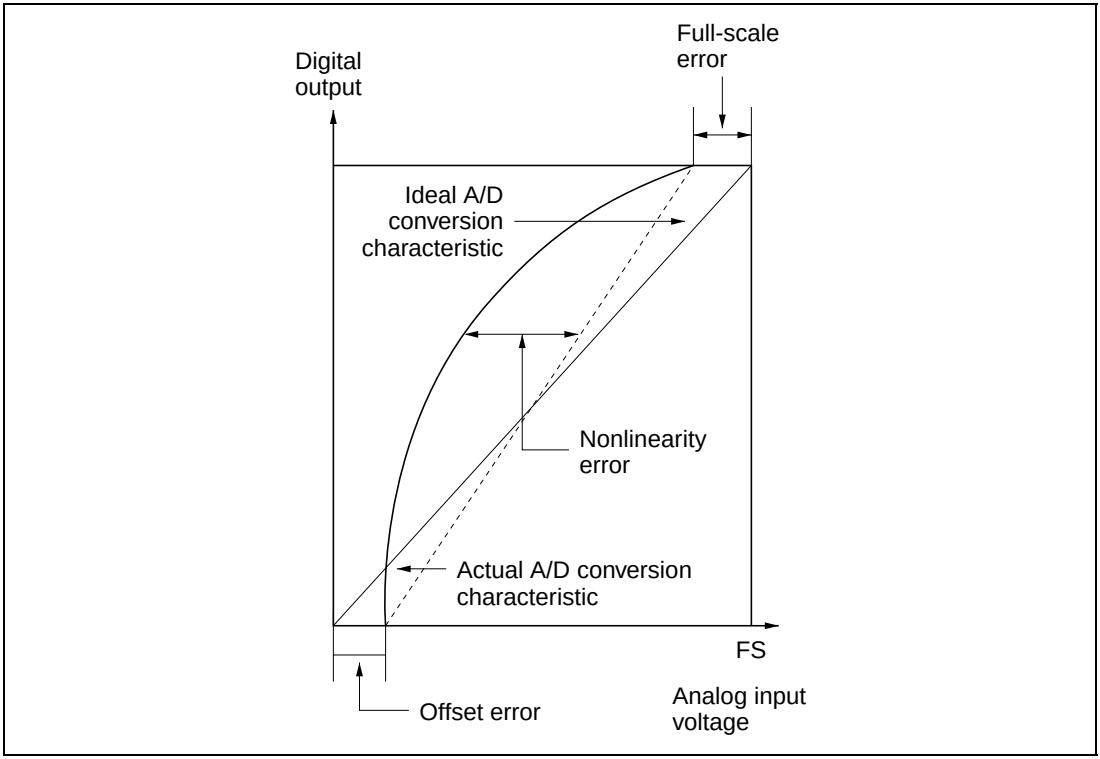


Figure 15.10 A/D Converter Accuracy Definitions (2)

7. Allowable Signal-Source Impedance: The analog inputs of the H8/3069R are designed to assure accurate conversion of input signals with a signal-source impedance not exceeding 10 kΩ. The reason for this rating is that it enables the input capacitor in the sample-and-hold circuit in the A/D converter to charge within the sampling time. If the sensor output impedance exceeds 10 kΩ, charging may be inadequate and the accuracy of A/D conversion cannot be guaranteed.

   If a large external capacitor is provided in single mode, then the internal 10-kΩ input resistance becomes the only significant load on the input. In this case the impedance of the signal source is not a problem.

   A large external capacitor, however, acts as a low-pass filter. This may make it impossible to track analog signals with high dv/dt (e.g. a variation of 5 mV/µs) (figure 15.11). To convert high-speed analog signals or to use scan mode, insert a low-impedance buffer.

8. Effect on Absolute Accuracy: Attaching an external capacitor creates a coupling with ground, so if there is noise on the ground line, it may degrade absolute accuracy. The capacitor must be connected to an electrically stable ground, such as AV_{SS}.

   If a filter circuit is used, be careful of interference with digital signals on the same board, and make sure the circuit does not act as an antenna.

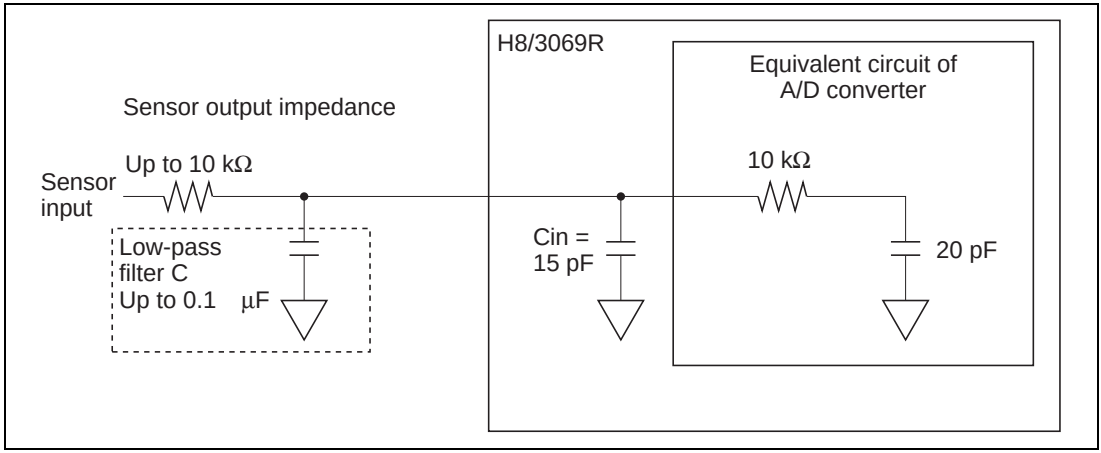


Figure 15.11 Analog Input Circuit (Example)

Section 16 D/A Converter

16.1 Overview

The H8/3069R includes a D/A converter with two channels.

16.1.1 Features

D/A converter features are listed below.

- Eight-bit resolution
- Two output channels
- Conversion time: maximum 10 µs (with 20-pF capacitive load)
- Output voltage: 0 V to V_{REF}
- D/A outputs can be sustained in software standby mode

16.1.2 Block Diagram

Figure 16.1 shows a block diagram of the D/A converter.

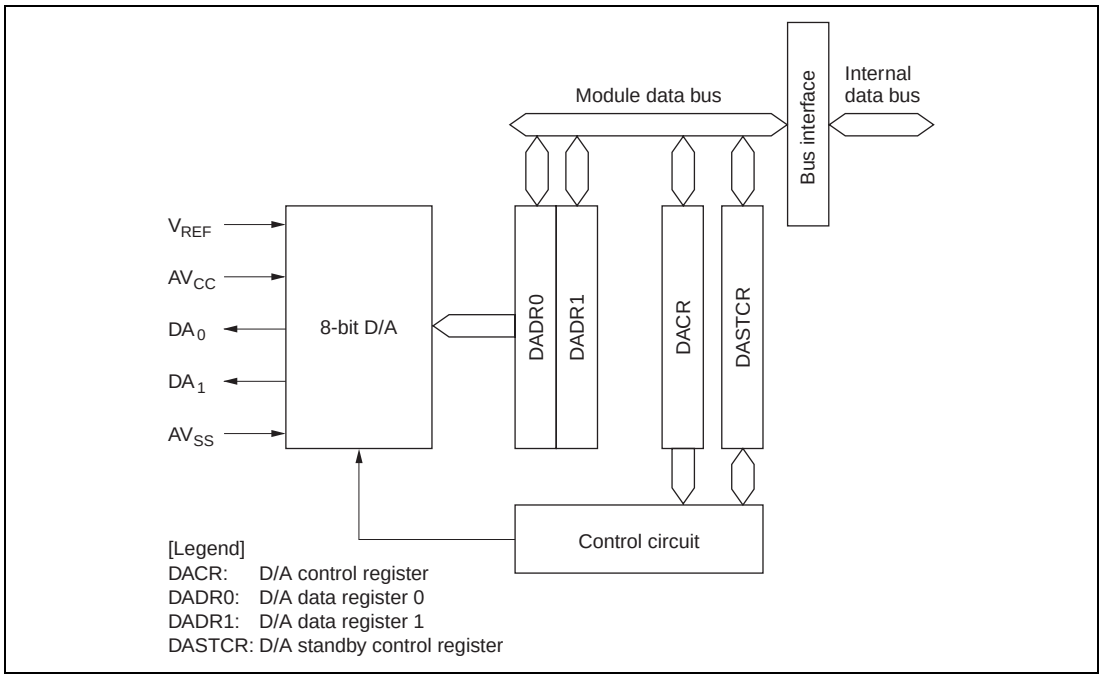


Figure 16.1 D/A Converter Block Diagram

16.1.3 Input/Output Pins

Table 16.1 summarizes the D/A converter's input and output pins.

Table 16.1 D/A Converter Pins

Pin Name	Abbreviation	I/O	Function
Analog power supply pin	AV_{CC}	Input	Analog power supply and reference voltage
Analog ground pin	AV_{SS}	Input	Analog ground and reference voltage
Analog output pin 0	DA_0	Output	Analog output, channel 0
Analog output pin 1	DA_1	Output	Analog output, channel 1
Reference voltage input pin	V_{REF}	Input	Analog reference voltage

16.1.4 Register Configuration

Table 16.2 summarizes the D/A converter's registers.

Table 16.2 D/A Converter Registers

Address*	Name	Abbreviation	R/W	Initial Value
H'FFF9C	D/A data register 0	DADR0	R/W	H'00
H'FFF9D	D/A data register 1	DADR1	R/W	H'00
H'FFF9E	D/A control register	DACR	R/W	H'1F
H'EE01A	D/A standby control register	DASTCR	R/W	H'FE

Note: * Lower 20 bits of the address in advanced mode.

16.2 Register Descriptions

16.2.1 D/A Data Registers 0 and 1 (DADR0/1)

Bit	7	6	5	4	3	2	1	0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

The D/A data registers (DADR0 and DADR1) are 8-bit readable/writable registers that store the data to be converted. When analog output is enabled, the D/A data register values are constantly converted and output at the analog output pins.

The D/A data registers are initialized to H'00 by a reset and in standby mode.

When the DASTE bit is set to 1 in the D/A standby control register (DASTCR), the D/A registers are not initialized in software standby mode.

16.2.2 D/A Control Register (DACR)

Bit	7	6	5	4	3	2	1	0
	DAOE1	DAOE0	DAE	—	—	—	—	—
Initial value	0	0	0	1	1	1	1	1
Read/Write	R/W	R/W	R/W	—	—	—	—	—

D/A enable
Controls D/A conversion

D/A output enable 0
Controls D/A conversion and analog output

D/A output enable 1
Controls D/A conversion and analog output

DACR is an 8-bit readable/writable register that controls the operation of the D/A converter. DACR is initialized to H'1F by a reset and in standby mode.

When the DASTE bit is set to 1 in DASTCR, the DACR is not initialized in software standby mode.

Bit 7—D/A Output Enable 1 (DAOE1): Controls D/A conversion and analog output.

Bit 7 DAOE1	Description
0	DA_1 analog output is disabled
1	Channel-1 D/A conversion and DA_1 analog output are enabled

Bit 6—D/A Output Enable 0 (DAOE0): Controls D/A conversion and analog output.

Bit 6 DAOE0	Description
0	DA_0 analog output is disabled
1	Channel-0 D/A conversion and DA_0 analog output are enabled

Bit 5—D/A Enable (DAE): Controls D/A conversion, together with bits DAOE0 and DAOE1. When the DAE bit is cleared to 0, analog conversion is controlled independently in channels 0 and 1. When the DAE bit is set to 1, analog conversion is controlled together in channels 0 and 1. Output of the conversion results is always controlled independently by DAOE0 and DAOE1.

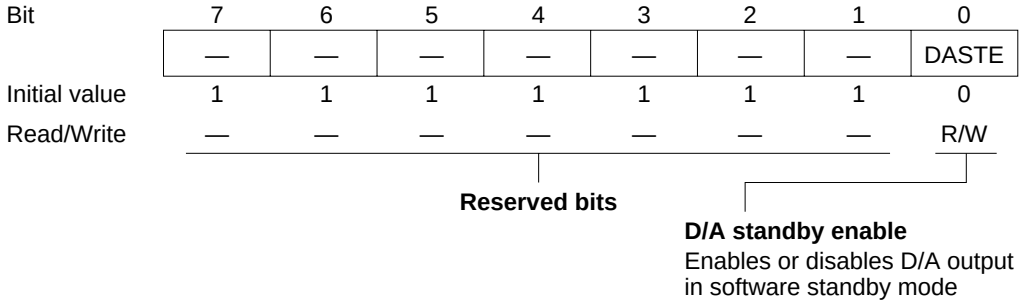
Bit 7 DAOE1	Bit 6 DAOE0	Bit 5 DAE	Description
0	0	—	D/A conversion is disabled in channels 0 and 1
	1	0	D/A conversion is enabled in channel 0
			D/A conversion is disabled in channel 1
		1	D/A conversion is enabled in channels 0 and 1
1	0	0	D/A conversion is disabled in channel 0
			D/A conversion is enabled in channel 1
		1	D/A conversion is enabled in channels 0 and 1
	1	—	D/A conversion is enabled in channels 0 and 1

When the DAE bit is set to 1, even if bits DAOE0 and DAOE1 in DACR and the ADST bit in ADCSR are cleared to 0, the same current is drawn from the analog power supply as during A/D and D/A conversion.

Bits 4 to 0—Reserved: These bits cannot be modified and are always read as 1.

16.2.3 D/A Standby Control Register (DASTCR)

DASTCR is an 8-bit readable/writable register that enables or disables D/A output in software standby mode.



DASTCR is initialized to H'FE by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bits 7 to 1—Reserved: These bits cannot be modified and are always read as 1.

Bit 0—D/A Standby Enable (DASTE): Enables or disables D/A output in software standby mode.

Bit 0 DASTE	Description	
0	D/A output is disabled in software standby mode	(Initial value)
1	D/A output is enabled in software standby mode	

16.3 Operation

The D/A converter has two built-in D/A conversion circuits that can perform conversion independently.

D/A conversion is performed constantly while enabled in DACR. If the DADR0 or DADR1 value is modified, conversion of the new data begins immediately. The conversion results are output when bits DAOE0 and DAOE1 are set to 1.

An example of D/A conversion on channel 0 is given next. Timing is indicated in figure 16.2.

1. Data to be converted is written in DADR0.
2. Bit DAOE0 is set to 1 in DACR. D/A conversion starts and DA0 becomes an output pin. The converted result is output after the conversion time.

   The output value is $\frac{\text{DADR contents}}{256} \bullet V_{REF}$

   Output of this conversion result continues until the value in DADR0 is modified or the DAOE0 bit is cleared to 0.
3. If the DADR0 value is modified, conversion starts immediately, and the result is output after the conversion time.
4. When the DAOE0 bit is cleared to 0, DA0 becomes an input pin.

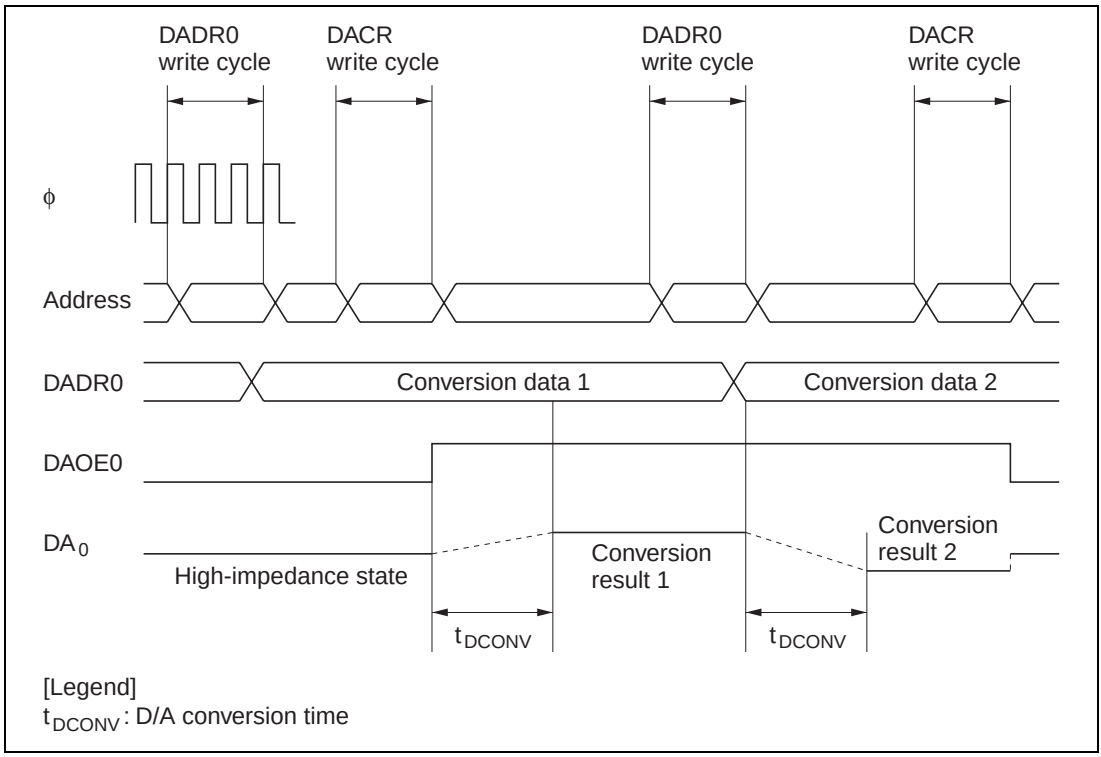


Figure 16.2 Example of D/A Converter Operation

16.4 D/A Output Control

In the H8/3069R, D/A converter output can be enabled or disabled in software standby mode.

When the DASTE bit is set to 1 in DASTCR, D/A converter output is enabled in software standby mode. The D/A converter registers retain the values they held prior to the transition to software standby mode.

When D/A output is enabled in software standby mode, the reference supply current is the same as during normal operation.

17.1 Overview

The H8/3069R has 16 kbytes RAM. The RAM is connected to the CPU by a 16-bit data bus. The CPU accesses both byte data and word data in two states, making the RAM useful for rapid data transfer.

The on-chip RAM of the H8/3069R is assigned to addresses H'FBF20 to H'FFF1F in modes 1, 2, and 7, and to addresses H'FFBF20 to H'FFFF1F in modes 3, 4, and 5. The RAM enable bit (RAME) in the system control register (SYSCR) can enable or disable the on-chip RAM.

17.1.1 Block Diagram

Figure 17.1 shows a block diagram of the on-chip RAM.

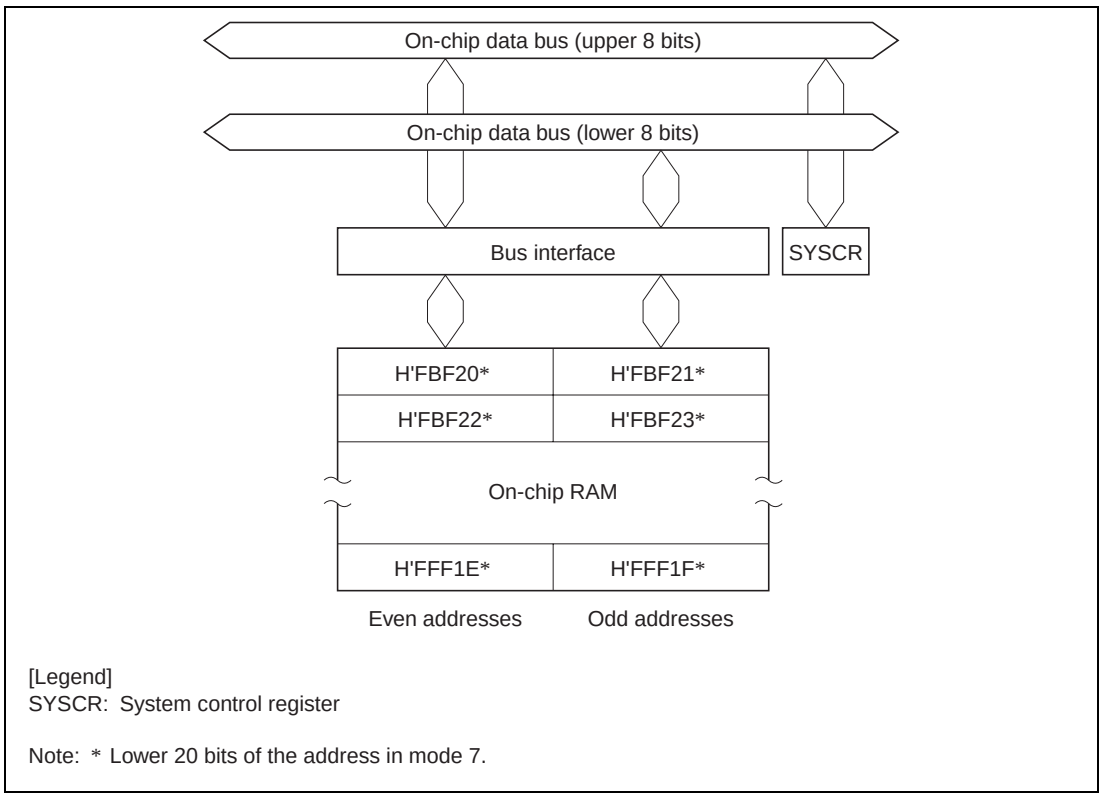


Figure 17.1 RAM Block Diagram

17.1.2 Register Configuration

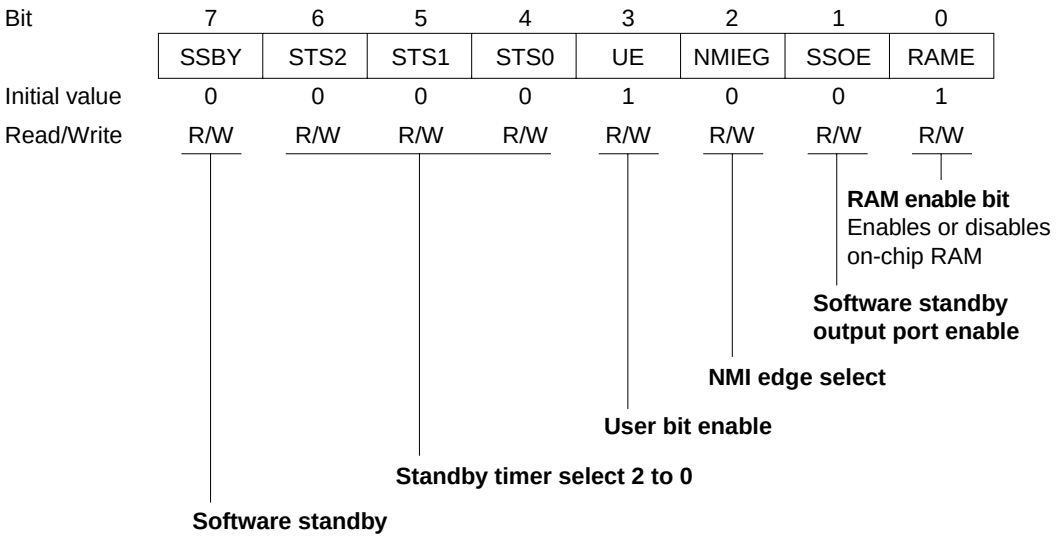
The on-chip RAM is controlled by SYSCR. Table 17.1 gives the address and initial value of SYSCR.

Table 17.1 System Control Register

Address*	Name	Abbreviation	R/W	Initial Value
H'EE012	System control register	SYSCR	R/W	H'09

Note: * Lower 20 bits of the address in advanced mode.

17.2 System Control Register (SYSCR)



One function of SYSCR is to enable or disable access to the on-chip RAM. The on-chip RAM is enabled or disabled by the RAME bit in SYSCR. For details about the other bits, see section 3.3, System Control Register (SYSCR).

Bit 0—RAM Enable (RAME): Enables or disables the on-chip RAM. The RAME bit is initialized at the rising edge of the input at the $\overline{\text{RES}}$ pin. It is not initialized in software standby mode.

Bit 0 RAME	Description	
0	On-chip RAM is disabled	
1	On-chip RAM is enabled	(Initial value)

17.3 Operation

When the RAME bit is set to 1, the on-chip RAM is enabled. Accesses to addresses H'FBF20 to H'FFF1F in modes 1, 2, and 7, and to addresses H'FFBF20 to H'FFFF1F in the H8/3069R in modes 3, 4, and 5, are directed to the on-chip RAM. In modes 1 to 5 (expanded modes), when the RAME bit is cleared to 0, the off-chip address space is accessed. In mode 7 (single-chip mode), when the RAME bit is cleared to 0, the on-chip RAM is not accessed: read access always results in H'FF data, and write access is ignored.

Since the on-chip RAM is connected to the CPU by an internal 16-bit data bus, it can be written and read by word access. It can also be written and read by byte access. Byte data is accessed in two states using the upper 8 bits of the data bus. Word data starting at an even address is accessed in two states using all 16 bits of the data bus.

Section 18 ROM

18.1 Features

This LSI has an on-chip 512-kbyte flash memory. The flash memory has the following features.

- Two flash-memory MATs according to LSI initiation mode

  The on-chip flash memory has two memory spaces in the same address space (hereafter referred to as memory MATs). The mode setting in the initiation determines which memory MAT is initiated first. The MAT can be switched by using the bank-switching method after initiation.

  — The user memory MAT is initiated at a power-on reset in user mode: 512 kbytes

  — The user boot memory MAT is initiated at a power-on reset in user boot mode:8 kbytes

- Three on-board programming modes and one off-board programming mode

  — On-board programming modes

Boot mode: This mode is a program mode that uses an on-chip SCI interface. The user MAT and user boot MAT can be programmed. This mode can automatically adjust the bit rate between host and this LSI.

User program mode: The user MAT can be programmed by using the optional interface.

User boot mode: The user boot program of the optional interface can be made and the user MAT can be programmed.

  — Off-board programming mode

PROM mode: This mode uses the PROM programmer. The user MAT and user boot MAT can be programmed.

- Programming/erasing interface by the download of on-chip program

  This LSI has a dedicated programming/erasing program. After downloading this program to the on-chip RAM, programming/erasing can be performed by setting the argument parameter.

  — User branch*

The program processing is performed in 128-byte units. It consists the program pulse application, verify read, and several other steps. Erasing is performed in one divided-block units and consists of several steps. The user processing routine can be executed between the steps, this setting for which is called the user branch addition.

Note: * Not available in the H8/3069R.

- Emulation function of flash memory by using the on-chip RAM

  As flash memory is overlapped with part of the on-chip RAM, the flash memory programming can be emulated in real time.
- Protection modes

  There are two protection modes: software protection by the register setting and hardware protection by the FWE pin. The protection state for flash memory programming/erasing can be set.

  When abnormalities, such as runaway of programming/erasing are detected, these modes enter the error protection state and the programming/erasing processing is suspended.
- Programming/erasing time

  The flash memory programming time is 3 ms (typ) in 128-byte simultaneous programming and 25 μs per byte. The erasing time is 1000 ms (typ) per 64 kbyte block.
- Number of programming

  The number of flash memory programming can be up to minimum 100 times.

18.2 Overview

18.2.1 Block Diagram

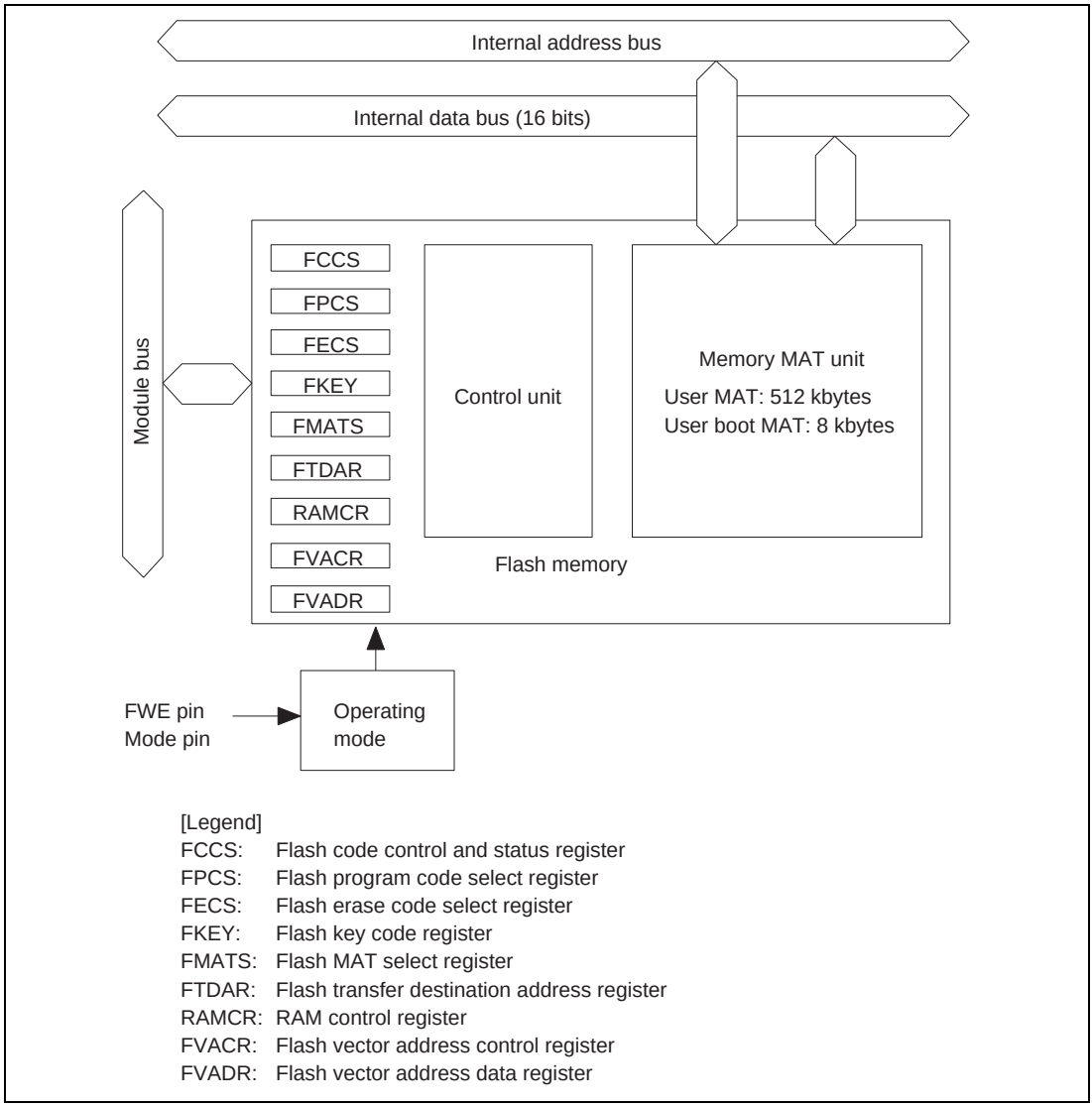


Figure 18. 1 Block Diagram of Flash Memory

18.2.2 Operating Mode

When each mode pin and the FWE pin are set in the reset state and reset start is performed, the microcomputer enters each operating mode as shown in figure 18.2. For the setting of each mode pin and the FWE pin, see table 18.1.

- Flash memory cannot be read, programmed, or erased in ROM invalid mode.
- Flash memory can be read in user mode, but cannot be programmed or erased.
- Flash memory can be read, programmed, or erased on the board only in user program mode, user boot mode, and boot mode.
- Flash memory can be read, programmed, or erased by means of the PROM programmer in PROM mode.

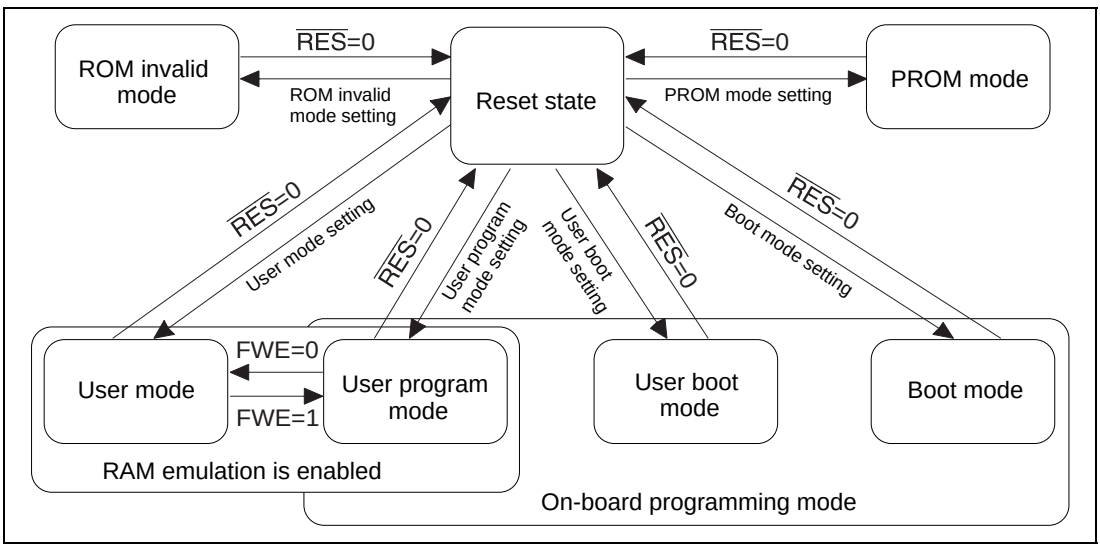


Figure 18.2 Mode Transition of Flash Memory

Table 18.1 Location of FWE and MD Pins and Operating Modes

	Mode						
Pin	Reset state	On-chip ROM invalid mode*	On-chip ROM valid mode*	User program mode	User boot mode	Boot mode	PROM mode
$\overline{\text{RES}}$	0	1	1	1	1	1	1
FWE	0/1	0	0	1	1	1	1
MD0	0/1	0/1	1	1	1	1	0
MD1	0/1	0/1	0/1	0/1	0/1	0/1	0
MD2	0/1	0	1	1	0	0	0
NMI	0/1	0/1	0/1	0/1	0	1	0/1

Note: * Modes 1 to 4 are on-chip ROM invalid modes.
Modes 5 and 7 are on-chip ROM valid modes. For details, see section 3, MCU Operating Modes.

18.2.3 Mode Comparison

The comparison table of programming and erasing related items about boot mode, user program mode, user boot mode, and PROM mode is shown in table 18.2.

Table 18.2 Comparison of Programming Modes

	Boot mode	User program mode	User boot mode	PROM mode
Programming/ Erasing Environment	On-board programming	On-board programming	On-board programming	Off-board programming
Programming/ Erasing Enable MAT	User MAT User boot MAT	User MAT	User MAT	User MAT User boot MAT
All Erasure	○(Automatic)	○	○	○(Automatic)
Block Division Erasure	○ *1	○	○	×
Program Data Transfer	From host via SCI	From optional device via RAM	From optional device via RAM	Via programmer
User Branch Function	×	×	×	×
RAM Emulation	×	○	×	×
Reset Initiation MAT	Embedded program storage MAT	User MAT	User boot MAT*2	—
Transition to User Mode	Mode setting change and reset	FWE setting change	Mode setting change and reset	—

Notes: 1. All-erasure is performed. After that, the specified block can be erased.
2. Initiation starts from the embedded program storage MAT. After checking the flash-memory related registers, initiation starts from the reset vector of the user MAT.

- The user boot MAT can be programmed or erased only in boot mode and PROM mode.
- The user MAT and user boot MAT are erased in boot mode. Then, the user MAT and user boot MAT can be programmed by means of the command method. However, the contents of the MAT cannot be read until this state.
  Only user boot MAT is programmed and the user MAT is programmed in user boot mode or only user MAT is programmed because user boot mode is not used.
- The boot operation of the optional interface can be performed by the mode pin setting different from user program mode in user boot mode.

18.2.4 Flash MAT Configuration

This LSI's flash memory is configured by the 512-kbyte user MAT and 8-kbyte user boot MAT.

The start address is allocated to the same address in the user MAT and user boot MAT. Therefore, when the program execution or data access is performed between two MATs, the MAT must be switched by using FMATS.

The user MAT or user boot MAT can be read in all modes if it is in ROM valid mode. However, the user boot MAT can be programmed only in boot mode and PROM mode.

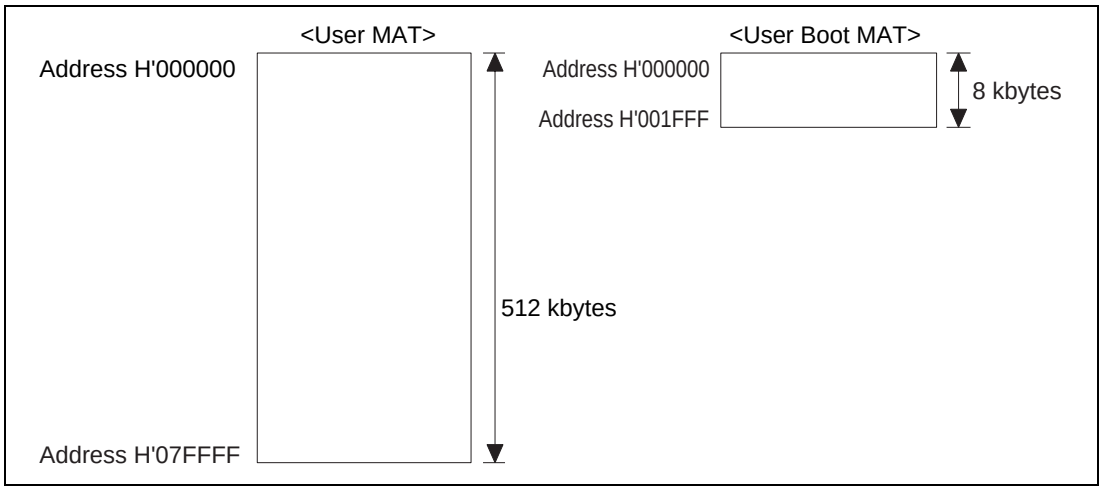


Figure 18.3 Flash Memory Configuration

The user MAT and user boot MAT have different memory sizes. Do not access a user boot MAT that is 8 kbytes or more. When a user boot MAT exceeding 8 kbytes is read from, an undefined value is read.

18.2.5 Block Division

The user MAT is divided into 64 kbytes (seven blocks), 32 kbytes (one block), and 4 kbytes (eight blocks) as shown in figure 18.4. The user MAT can be erased in this divided-block units and the erase-block number of EB0 to EB15 is specified when erasing.

The RAM emulation can be performed in the eight blocks of 4 kbytes.

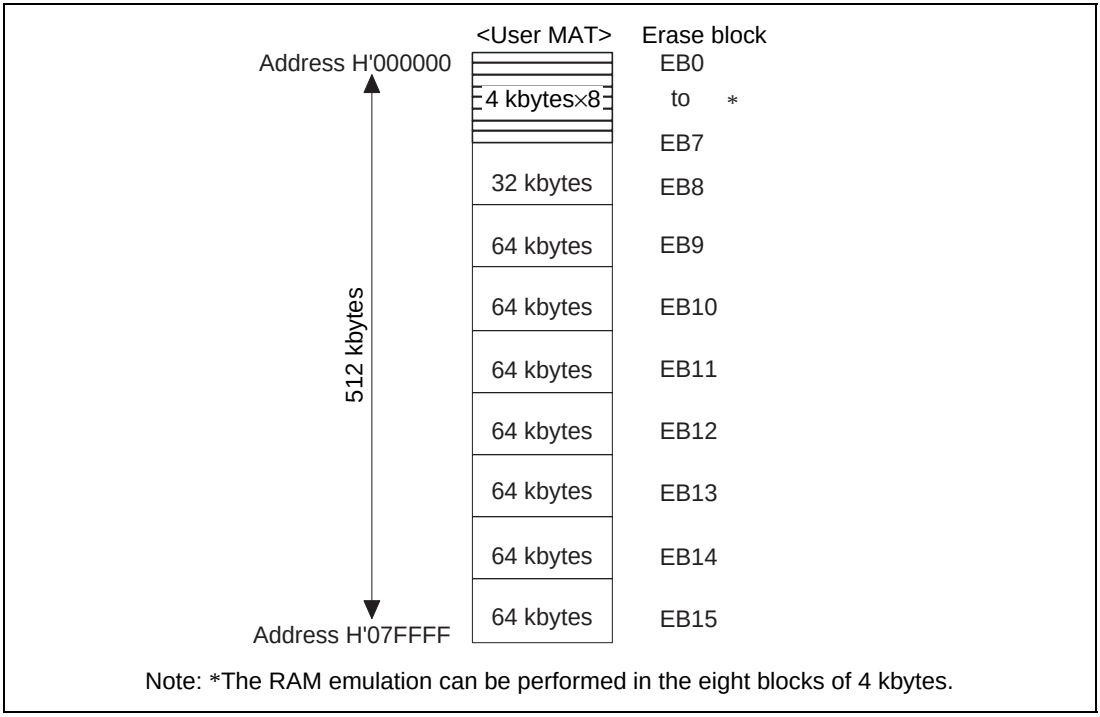


Figure 18.4 Block Division of User MAT

18.2.6 Programming/Erasing Interface

Programming/erasing is executed by downloading the on-chip program to the on-chip RAM and specifying the program address/data and erase block by using the interface register/parameter.

The procedure program is made by the user in user program mode and user boot mode. The overview of the procedure is as follows. For details, see section 18.5.2, User Program Mode.

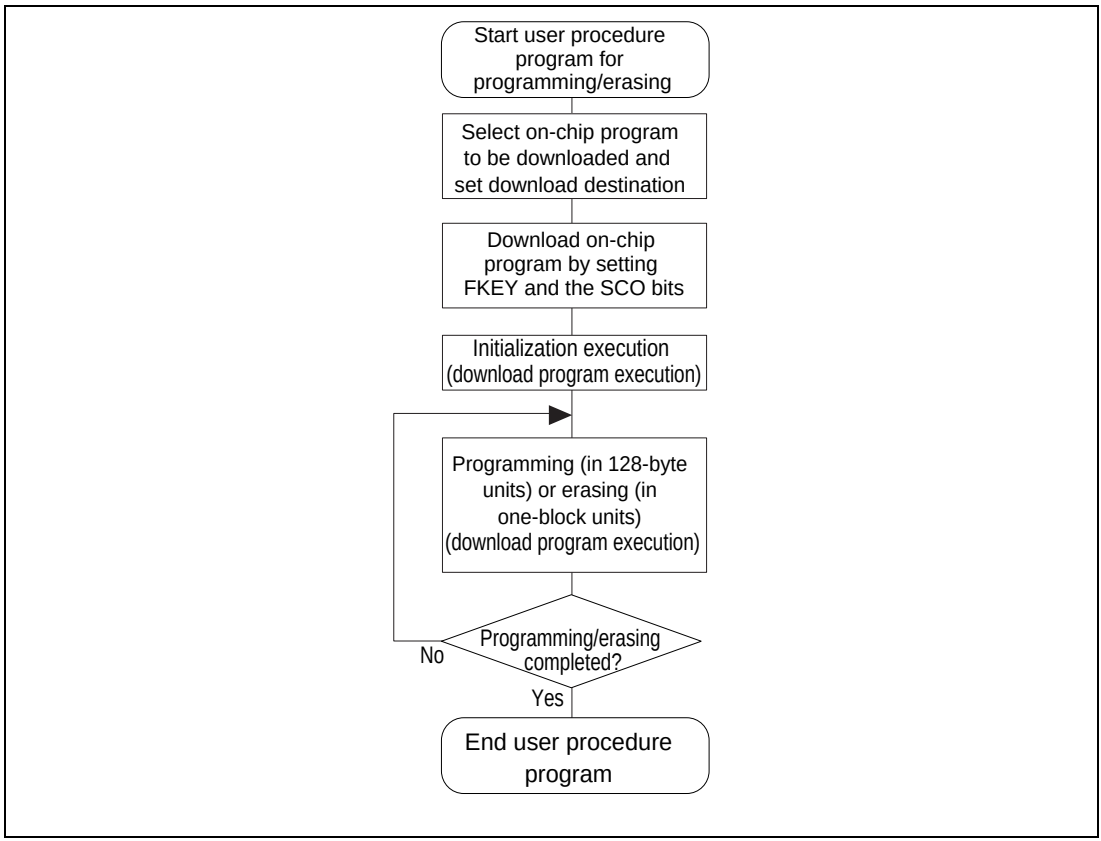


Figure 18.5 Overview of User Procedure Program

1. Selection of on-chip program to be downloaded and setting of download destination

This LSI has programming/erasing programs and they can be downloaded to the on-chip RAM. The on-chip program to be downloaded is selected by setting the corresponding bits in the programming/erasing interface register. The download destination can be specified by FTDAR.

2. Download of on-chip program

The on-chip program is automatically downloaded by setting the SCO bit in the flash key code register (FKEY) and the flash code control and status register (FCCS), which are programming/erasing interface registers.

The user MAT is replaced to the embedded program storage area when downloading. Since the flash memory cannot be read when programming/erasing, the procedure program, which is working from download to completion of programming/erasing, must be executed in a space other than the flash memory to be programmed/erased (for example, on-chip RAM).

Since the result of download is returned to the programming/erasing interface parameters, whether the normal download is executed or not can be confirmed.

3. Initialization of programming/erasing

The operating frequency and user branch are set before execution of programming/erasing. The user branch destination must be area other than the flash memory area or the area where the on-chip program is downloaded. These settings are performed by using the programming/erasing interface parameters.

4. Programming/erasing execution

To program or erase, the FWE pin must be set to 1 and user program mode must be entered.

The program data/programming destination address is specified in 128-byte units when programming.

The block to be erased is specified in erase-block units when erasing.

These specifications are set by using the programming/erasing interface parameters and the on-chip program is initiated. The on-chip program is executed by using the JSR or BSR instruction to perform the subroutine call of the specified address in the on-chip RAM. The execution result is returned to the programming/erasing interface parameters.

The area to be programmed must be erased in advance when programming flash memory.

All interrupts are prohibited during programming and erasing. Interrupts must not occur in the user system.

5. When programming/erasing is executed consecutively

When the processing is not ended by the 128-byte programming or one-block erasure, the program address/data and erase-block number must be updated and consecutive programming/erasing is required.

Since the downloaded on-chip program is left in the on-chip RAM after the processing, download and initialization are not required when the same processing is executed consecutively.

18.3 Pin Configuration

Flash memory is controlled by the pin as shown in table 18.3.

Table 18.3 Pin Configuration

Pin Name	Abbreviation	Input/Output	Function
Reset	$\overline{\text{RES}}$	Input	Reset
Flash programming enable	FWE	Input	Hardware protection when programming flash memory
Mode 2	MD2	Input	Sets operating mode of this LSI
Mode 1	MD1	Input	Sets operating mode of this LSI
Mode 0	MD0	Input	Sets operating mode of this LSI
Non-maskable interrupt	NMI	Input	Sets operating mode of this LSI
Transmit data	TxD1	Output	Serial transmit data output (used in boot mode)
Receive data	RxD1	Input	Serial receive data input (used in boot mode)

Note: For the pin configuration in PROM mode, see section 18.9, PROM Mode.

18.4 Register Configuration

18.4.1 Registers

The registers/parameters which control flash memory when the on-chip flash memory is valid are shown in table 18.4.

There are several operating modes for accessing flash memory, for example, read mode/program mode.

There are two memory MATs: user MAT and user boot MAT. The dedicated registers/parameters are allocated for each operating mode and MAT selection. The correspondence of operating modes and registers/parameters for use is shown in table 18.5.

Table 18.4 (1) Register Configuration

Name	Abbreviation	R/W	Initial Value	Address	Access Size
Flash code control status register	FCCS	R, W*[1]	H'00*[2] H'80*[2]	H'EE0B0	8
Flash program code select register	FPCS	R/W	H'00	H'EE0B1	8
Flash erase code select register	FECS	R/W	H'00	H'EE0B2	8
Flash key code register	FKEY	R/W	H'00	H'EE0B4	8
Flash MAT select register	FMATS	R/W	H'00*[3] H'AA*[3]	H'EE0B5	8
Flash transfer destination address register	FTDAR	R/W	H'00	H'EE0B6	8
RAM control register	RAMCR	R/W	H'F0	H'EE077	8
Flash vector address code control register	FVACR	R/W	H'00	H'EE0B7	8
Flash vector address data register R	FVADRR	R/W	H'00	H'EE0B8	8
Flash vector address data register E	FVADRE	R/W	H'00	H'EE0B9	8
Flash vector address data register H	FVADRH	R/W	H'00	H'EE0BA	8
Flash vector address data register L	FVADRL	R/W	H'00	H'EE0BB	8

Notes: 1. The bits except the SCO bit are read-only bits. The SCO bit is a programming-only bit. (The value which can be read is always 0.)

2. The initial value is H'00 when the FWE pin goes low.
   The initial value is H'80 when the FWE pin goes high.

3. The initial value at initiation in user mode or user program mode is H'00.
   The initial value at initiation in user boot mode is H'AA.

Table 18.4 (2) Parameter Configuration

Name	Abbreviation	R/W	Initial Value	Address	Access Size
Download pass/fail result	DPFR	R/W	Undefined	On-chip RAM*	8, 16, 32
Flash pass/fail result	FPFR	R/W	Undefined	R0L of CPU	8, 16, 32
Flash multipurpose address area	FMPAR	R/W	Undefined	ER1 of CPU	8, 16, 32
Flash multipurpose data destination area	FMPDR	R/W	Undefined	ER0 of CPU	8, 16, 32
Flash erase block select	FEBS	R/W	Undefined	ER0 of CPU	8, 16, 32
Flash program and erase frequency control	FPEFEQ	R/W	Undefined	ER0 of CPU	8, 16, 32
Flash user branch address set parameter	FUBRA	R/W	Undefined	ER1 of CPU	8, 16, 32

Note: * One byte of the start address in the on-chip RAM area specified by FTDAR is valid.

Table 18.5 Register/Parameter and Target Mode

		Download	Initialization	Programming	Erasure	Read	RAM Emulation
Programming/ erasing interface registers	FCCS	○	—	—	—	—	—
	FPCS	○	—	—	—	—	—
	PECS	○	—	—	—	—	—
	FKEY	○	—	○	○	—	—
	FMATS	—	—	○ *1	○ *1	○ *2	—
	FTDAR	○	—	—	—	—	—
Programming/ erasing interface parameter	DPFR	○	—	—	—	—	—
	FPFR	—	○	○	○	—	—
	FPEFEQ	—	○	—	—	—	—
	FUBRA	—	○	—	—	—	—
	FMPAR	—	—	○	—	—	—
	FMPDR	—	—	○	—	—	—
	FEBS	—	—	—	○	—	—
RAM emulation	RAMCR	—	—	—	—	—	○

Notes: 1. The setting is required when programming or erasing user MAT in user boot mode.
2. The setting may be required according to the combination of initiation mode and read target MAT.

18.4.2 Programming/Erasing Interface Register

The programming/erasing interface registers are as described below. They are all 8-bit registers that can be accessed in byte. Except for the FLER bit in FCCS, these registers are initialized at a power-on reset, in hardware standby mode, or in software standby mode. The FLER bit is not initialized in software standby mode.

(1) Flash Code Control and Status Register (FCCS)

FCCS is configured by bits which request the monitor of the FWE pin state and error occurrence during programming or erasing flash memory and the download of on-chip program.

Bit :	7	6	5	4	3	2	1	0
	FWE	—	—	FLER	—	—	—	SCO
Initial value :	1/0	0	0	0	0	0	0	0
R/W :	R	R	R	R	R	R	R	(R)W

Bit 7—Flash Programming Enable (FWE): Monitors level which is input to the FWE pin that performs hardware protection of the flash memory programming or erasing. The initial value is 0 or 1 according to the FWE pin state.

Bit 7	
FWE	**Description**
0	When the FWE pin goes low (in hardware protection state)
1	When the FWE pin goes high

Bits 6 and 5—Reserved: These bits are always read as 0. The write value should always be 0.

Bit 4—Flash Memory Error (FLER): Indicates an error occurs during programming and erasing flash memory.

When FLER is set to 1, flash memory enters the error protection state.

This bit is initialized at a power-on reset or in hardware standby mode.

When FLER is set to 1, high voltage is applied to the internal flash memory. To reduce the damage to flash memory, the reset must be released after the reset period of 100 µs which is longer than normal.

Bit 4	
FLER	**Description**
0	Flash memory operates normally (Initial value) Programming/erasing protection for flash memory (error protection) is invalid. [Clearing condition] At a power-on reset or in hardware standby mode
1	Indicates an error occurs during programming/erasing flash memory. Programming/erasing protection for flash memory (error protection) is valid. [Setting condition] See section 18.6.3, Error Protection.

Bits 3 to 1—Reserved: These bits are always read as 0. The write value should always be 0.

Bit 0—Source Program Copy Operation (SCO): Requests the on-chip programming/erasing program to be downloaded to the on-chip RAM.

When this bit is set to 1, the on-chip program which is selected by FPCS/FECS is automatically downloaded in the on-chip RAM area specified by FTDAR.

In order to set this bit to 1, RAM emulation state must be canceled, H'A5 must be written to FKEY, and this operation must be in the on-chip RAM.

Four NOP instructions must be executed immediately after setting this bit to 1.

Since this bit is cleared to 0 when download is completed, this bit cannot be read as 1.

All interrupts are prohibited during programming and erasing. Interrupts must not occur in the user system.

Bit 0

SCO	Description
0	Download of the on-chip programming/erasing program to the on-chip RAM is not executed (Initial value) [Clear condition] When download is completed
1	Request that the on-chip programming/erasing program is downloaded to the on-chip RAM is occurred [Clear conditions] When all of the following conditions are satisfied and 1 is written to this bit • FKEY is written to H'A5 • During execution in the on-chip RAM • Not in RAM emulation mode (RAMS in RAMCR = 0)

(2) Flash Program Code Select Register (FPCS)

FPCS selects the on-chip programming program to be downloaded.

Bit :	7	6	5	4	3	2	1	0
	—	—	—	—	—	—	—	PPVS
Initial value :	0	0	0	0	0	0	0	0
R/W :	R	R	R	R	R	R	R	R/W

Bits 7 to 1—Reserved: These bits are always read as 0. The write value should always be 0.

Bit 0—Program Pulse Verify (PPVS): Selects the programming program.

Bit 0

PPVS	Description
0	On-chip programming program is not selected (Initial value) [Clear condition] When transfer is completed
1	On-chip programming program is selected

(3) Flash Erase Code Select Register (FECS)

FECS selects download of the on-chip erasing program.

Bit :	7	6	5	4	3	2	1	0
	—	—	—	—	—	—	—	EPVB
Initial value :	0	0	0	0	0	0	0	0
R/W :	R	R	R	R	R	R	R	R/W

Bits 7 to 1—Reserved: These bits are always read as 0. The write value should always be 0.

Bit 0—Erase Pulse Verify Block (EPVB): Selects the erasing program.

Bit 0		
EPVB	**Description**	
0	On-chip erasing program is not selected	(Initial value)
	[Clear condition] When transfer is completed	
1	On-chip erasing program is selected	

(4) Flash Key Code Register (FKEY)

FKEY is a register for software protection that enables download of on-chip program and programming/erasing of flash memory. Before setting the SCO bit to 1 in order to download on-chip program or executing the downloaded programming/erasing program, these processing cannot be executed if the key code is not written.

Bit :	7	6	5	4	3	2	1	0
	K7	K6	K5	K4	K3	K2	K1	K0
Initial value :	0	0	0	0	0	0	0	0
R/W :	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Bits 7 to 0—Key Code (K7 to K0): Only when H'A5 is written, writing to the SCO bit is valid. When the value other than H'A5 is written to FKEY, 1 cannot be written to the SCO bit. Therefore downloading to the on-chip RAM cannot be executed.

Only when H'5A is written, programming/erasing can be executed. Even if the on-chip programming/erasing program is executed, flash memory cannot be programmed or erased when the value other than H'5A is written to FKEY.

Bits 7 to 0

K7 to K0	Description
H'A5	Writing to the SCO bit is enabled (The SCO bit cannot be set by the value other than H'A5.)
H'5A	Programming/erasing is enabled (The value other than H'5A is in software protection state.)
H'00	Initial value

(5) Flash MAT Select Register (FMATS)

FMATS specifies whether user MAT or user boot MAT is selected.

Bit :	7	6	5	4	3	2	1	0	
	MS7	MS6	MS5	MS4	MS3	MS2	MS1	MS0	
Initial value :	0	0	0	0	0	0	0	0	(When not in user boot mode)
Initial value :	1	0	1	0	1	0	1	0	(When in user boot mode)
R/W :	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	

Bits 7 to 0—MAT Select (MS7 to MS0): These bits are in user-MAT selection state when the value other than H'AA is written and in user-boot-MAT selection state when H'AA is written.

The MAT is switched by writing the value in FMATS.

When the MAT is switched, follow section 18.8, Switching between User MAT and User Boot MAT. (The user boot MAT cannot be programmed in user programming mode if user boot MAT is selected by FMATS. The user boot MAT must be programmed in boot mode or in PROM mode.)

Bits 7 to 0

MS7 to MS0	Description
H'AA	The user boot MAT is selected (in user-MAT selection state when the value of these bits are other than H'AA) Initial value when these bits are initiated in user boot mode.
H'00	Initial value when these bits are initiated in a mode except for user boot mode (in user-MAT selection state)

[Programmable condition] These bits are in the execution state in the on-chip RAM.

(6) Flash Transfer Destination Address Register (FTDAR)

FTDAR specifies the on-chip RAM address to which the on-chip program is downloaded. Make settings for FTDAR before writing 1 to the SCO bit in FCCS. The initial value is H'00 which points to the start address (H'FFEF20) in on-chip RAM.

Bit :	7	6	5	4	3	2	1	0
	TDER	TDA6	TDA5	TDA4	TDA3	TDA2	TDA1	TDA0
Initial value :	0	0	0	0	0	0	0	0
R/W :	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Bit 7—Transfer Destination Address Setting Error (TDER): This bit is set to 1 when there is an error in the download start address set by bits 6 to 0 (TDA6 to TDA0). Whether the address setting is erroneous or not is judged by checking whether the setting of TDA6 to TDA0 is between the range of H'00 and H'03 after setting the SCO bit in FCCS to 1 and performing download. Before setting the SCO bit to 1 be sure to set the FTDAR value between H'00 to H'03 as well as clearing this bit to 0.

Bit 7

TDER	Description(Return Value after Download)	
0	Setting of TDA6 to TDA0 is normal	(Initial value)
1	Setting of TDER and TDA6 to TDA0 is H'04 to H'FF and download has been aborted	

Bits 6 to 0—Transfer Destination Address (TDA6 to TDA0): These bits specify the download start address. A value from H'00 to H'03 can be set to specify the download start address in on-chip RAM in 4-kbyte units.

A value from H'04 to H'7F cannot be set. If such a value is set, the TDER bit (bit 7) in this register is set to 1 to prevent download from being executed.

Bits 6 to 0

TDA6 to TDA0	Description	
H'00	Download start address is set to H'FFEF20	(Initial value)
H'01	Download start address is set to H'FFDF20	
H'02	Download start address is set to H'FFCF20	
H'03	Download start address is set to H'FFBF20	
H'04 to H'FF	Setting prohibited. If this value is set, the TDER bit (bit 7) is set to 1 to abort the download processing.	

18.4.3 Programming/Erasing Interface Parameter

The programming/erasing interface parameter specifies the operating frequency, user branch destination address, storage place for program data, programming destination address, and erase block and exchanges the processing result for the downloaded on-chip program. This parameter uses the general registers of the CPU (ER0 and ER1) or the on-chip RAM area. The initial value is undefined at a power-on reset or in hardware standby mode.

When download, initialization, or on-chip program is executed, registers of the CPU except for R0L are stored. The return value of the processing result is written in R0L. Since the stack area is used for storing the registers except for R0L, the stack area must be saved at the processing start. (A maximum size of a stack area to be used is 128 bytes.)

The programming/erasing interface parameter is used in the following four items.

(1) Download control
(2) Initialization before programming or erasing
(3) Programming
(4) Erasing

These items use different parameters. The correspondence table is shown in table 18.6.

Here the FPFR parameter returns the results of initialization processing, programming processing, or erasing processing, but the meaning of the bits differs depending on the type of processing. For details, refer to the FPFR descriptions for the individual processes.

Table 18.6 Usable Parameters and Target Modes

Name of Parameter	Abbreviation	Download	Initialization	Programming	Erasure	R/W	Initial Value	Allocation
Download pass/fail result	DPFR	○	—	—	—	R/W	Undefined	On-chip RAM*
Flash pass/fail result	FPFR	—	○	○	○	R/W	Undefined	R0L of CPU
Flash programming/ erasing frequency control	FPEFEQ	—	○	—	—	R/W	Undefined	ER0 of CPU
Flash user branch address set parameter	FUBRA	—	○	—	—	R/W	Undefined	ER1 of CPU
Flash multipurpose address area	FMPAR	—	—	○	—	R/W	Undefined	ER1 of CPU
Flash multipurpose data destination area	FMPDR	—	—	○	—	R/W	Undefined	ER0 of CPU
Flash erase block select	FEBS	—	—	—	○	R/W	Undefined	ER0 of CPU

Note: * One byte of start address of download destination specified by FTDAR

(1) Download Control

The on-chip program is automatically downloaded by setting the SCO bit to 1. The on-chip RAM area to be downloaded is the area as much as 4 kbytes starting from the start address specified by FTDAR. For the address map of the on-chip RAM, see figure 18.10.

The download control is set by using the programming/erasing interface register. The return value is given by the DPFR parameter.

(a) Download pass/fail result parameter (DPFR: one byte of start address of on-chip RAM specified by FTDAR)

This parameter indicates the return value of the download result. The value of this parameter can be used to determine if downloading is executed or not. Since the confirmation whether the SCO bit is set to 1 is difficult, the certain determination must be performed by setting one byte of the start address of the on-chip RAM area specified by FTDAR to a value other than the return value of download (for example, H'FF) before the download start (before setting the SCO bit to 1). Refer to item 18.5.2 (e) for information on the method for checking the download result.

Bit :	7	6	5	4	3	2	1	0
	0	0	0	0	0	SS	FK	SF

Bits 7 to 3—Unused: Return 0.

Bit 2—Source Select Error Detect (SS): The on-chip program which can be downloaded can be specified only one type. When more than two types of the program are selected, the program is not selected, or the program is selected without mapping, error is occurred.

Bit 2

SS	Description
0	Download program can be selected normally
1	Download error is occurred (Multi-selection or program which is not mapped is selected)

Bit 1—Flash Key Register Error Detect (FK): Returns the check result whether the value of FKEY is set to H'A5.

Bit 1

FK	Description
0	FKEY setting is normal (FKEY = H'A5)
1	Setting value of FKEY becomes error (FKEY = value other than H'A5)

Bit 0—Success/Fail (SF): Returns the result whether download is ended normally or not. The judgement result whether program that is downloaded to the on-chip RAM is read back and then transferred to the on-chip RAM is returned.

Bit 0

SF	Description
0	Downloading on-chip program is ended normally (no error)
1	Downloading on-chip program is ended abnormally (error occurs)

(2) Programming/Erasing Initialization

The on-chip programming/erasing program to be downloaded includes the initialization program.

The specified period pulse must be applied when programming or erasing. The specified pulse width is made by the method in which wait loop is configured by the CPU instruction. The operating frequency of the CPU must be set.

The initial program is set as a parameter of the programming/erasing program which has downloaded these settings.

(a) Flash programming/erasing frequency parameter (FPEFEQ: general register ER0 of CPU)

This parameter sets the operating frequency of the CPU.

For the range of the operating frequency of this LSI, see section 21.4.1, Clock Timing.

Bit :	31	30	29	28	27	26	25	24
	0	0	0	0	0	0	0	0
Bit :	23	22	21	20	19	18	17	16
	0	0	0	0	0	0	0	0
Bit :	15	14	13	12	11	10	9	8
	F15	F14	F13	F12	F11	F10	F9	F8
Bit :	7	6	5	4	3	2	1	0
	F7	F6	F5	F4	F3	F2	F1	F0

Bits 31 to 16—Unused: Only 0 may be written to these bits.

Bits 15 to 0—Frequency Set (F15 to F0): Set the operating frequency of the CPU. The setting value must be calculated as the following methods.

1. The operating frequency which is shown in MHz units must be rounded in a number to three decimal places and be shown in a number of two decimal places.
2. The centuplicated value is converted to the binary digit and is written to the FPEFEQ parameter (general register R0). For example, when the operating frequency of the CPU is 25.000 MHz, the value is as follows.
    - The number to three decimal places of 25.000 is rounded and the value is thus 25.00.
    - The formula that $25.00 \times 100 = 2500$ is converted to the binary digit and b'0000,1001,1100,0100 (H'09C4) is set to R0.

(b) Flash user branch address setting parameter (FUBRA: general register ER1 of CPU)

This parameter sets the user branch destination address. The user program which has been set can be executed in specified processing units when programming and erasing.

Bit :	31	30	29	28	27	26	25	24
	UA31	UA30	UA29	UA28	UA27	UA26	UA25	UA24
Bit :	23	22	21	20	19	18	17	16
	UA23	UA22	UA21	UA20	UA19	UA18	UA17	UA16
Bit :	15	14	13	12	11	10	9	8
	UA15	UA14	UA13	UA12	UA11	UA10	UA9	UA8
Bit :	7	6	5	4	3	2	1	0
	UA7	UA6	UA5	UA4	UA3	UA2	UA1	UA0

Bits 31 to 0—User Branch Destination Address (UA31 to UA0): Not available in the H8/3069R, address 0 (H'00000000) must be set.

The user branch destination must be the area other than the RAM area in which on-chip program has been transferred or the external bus space.

Note that the CPU must not branch to an area without the execution code and get out of control. The on-chip program download area and stack area must not be overwritten. If CPU runaway occurs or the download area or stack area is overwritten, the value of flash memory cannot be guaranteed.

The download of on-chip program, initialization, initiation of the programming/erasing program must not be executed in the processing of the user branch destination. Programming or erasing cannot be guaranteed when returning from the user branch destination. The program data which has already been prepared must not be programmed.

Moreover, the programming/erasing interface register must not be programmed or RAM emulation mode must not be entered in the processing of the user branch destination.

After the processing of the user branch is ended, the programming/erasing program must be returned by using the RTS instruction.

(c) Flash pass/fail parameter (FPFR: general register R0L of CPU)

An explanation of FPFR as the return value indicating the initialization result is provided here.

Bit :	7	6	5	4	3	2	1	0
	0	0	0	0	0	BR	FQ	SF

Bits 7 to 3—Unused: Return 0.

Bit 2—User Branch Error Detect (BR): Returns the check result whether the specified user branch destination address is in the area other than the storage area of the programming/erasing program which has been downloaded .

Bit 2	
BR	**Description**
0	User branch address setting is normal
1	User branch address setting is abnormal

Bit 1—Frequency Error Detect (FQ): Returns the check result whether the specified operating frequency of the CPU is in the range of the supported operating frequency.

Bit 1	
FQ	**Description**
0	Setting of operating frequency is normal
1	Setting of operating frequency is abnormal

Bit 0—Success/Fail (SF): Indicates whether initialization is completed normally.

Bit 0	
SF	**Description**
0	Initialization is ended normally (no error)
1	Initialization is ended abnormally (error occurs)

(3) Programming Execution

When flash memory is programmed, the programming destination address on the user MAT must be passed to the programming program in which the program data is downloaded.

1. The start address of the programming destination on the user MAT is set in general register ER1 of the CPU. This parameter is called FMPAR (flash multipurpose address area parameter).
   Since the program data is always in 128-byte units, the lower eight bits (MOA7 to MOA0) must be H'00 or H'80 as the boundary of the programming start address on the user MAT.
2. The program data for the user MAT must be prepared in the consecutive area. The program data must be in the consecutive space which can be accessed by using the MOV.B instruction of the CPU and is not the flash memory space.
   When data to be programmed does not satisfy 128 bytes, the 128-byte program data must be prepared by embedding the dummy code (H'FF).
   The start address of the area in which the prepared program data is stored must be set in general register ER0. This parameter is called FMPDR (flash multipurpose data destination area parameter).

For details on the programming procedure, see section 18.5.2, User Program Mode.

(a) Flash multipurpose address area parameter (FMPAR: general register ER1 of CPU)

This parameter indicates the start address of the programming destination on the user MAT. When an address in an area other than the flash memory space is set, an error occurs.
The start address of the programming destination must be at the 128-byte boundary. If this boundary condition is not satisfied, an error occurs. The error occurrence is indicated by the WA bit (bit 1) in FPFR.

FMPAR

Bit :	31	30	29	28	27	26	25	24
	MOA31	MOA30	MOA29	MOA28	MOA27	MOA26	MOA25	MOA24
Bit :	23	22	21	20	19	18	17	16
	MOA23	MOA22	MOA21	MOA20	MOA19	MOA18	MOA17	MOA16
Bit :	15	14	13	12	11	10	9	8
	MOA15	MOA14	MOA13	MOA12	MOA11	MOA10	MOA9	MOA8
Bit :	7	6	5	4	3	2	1	0
	MOA7	MOA6	MOA5	MOA4	MOA3	MOA2	MOA1	MOA0

Bits 31 to 0—MOA31 to MOA0: Store the start address of the programming destination on the user MAT. The consecutive 128-byte programming is executed starting from the specified start address of the user MAT. Therefore, the specified programming start address becomes a 128-byte boundary and MOA6 to MOA0 are always 0.

(b) Flash multipurpose data destination parameter (FMPDR: general register ER0 of CPU):

This parameter indicates the start address in the area which stores the data to be programmed in the user MAT. When the storage destination of the program data is in flash memory, an error occurs. The error occurrence is indicated by the WD bit (bit 2) in FPFR.

FMPDR

Bit :	31	30	29	28	27	26	25	24
	MOD31	MOD30	MOD29	MOD28	MOD27	MOD26	MOD25	MOD24
Bit :	23	22	21	20	19	18	17	16
	MOD23	MOD22	MOD21	MOD20	MOD19	MOD18	MOD17	MOD16
Bit :	15	14	13	12	11	10	9	8
	MOD15	MOD14	MOD13	MOD12	MOD11	MOD10	MOD9	MOD8
Bit :	7	6	5	4	3	2	1	0
	MOD7	MOD6	MOD5	MOD4	MOD3	MOD2	MOD1	MOD0

Bits 31 to 0—MOD31 to MOD0: Store the start address of the area which stores the program data for the user MAT. The consecutive 128-byte data is programmed to the user MAT starting from the specified start address.

(c) Flash pass/fail parameter (FPFR: general register R0L of CPU)

An explanation of FPFR as the return value indicating the programming result is provided here.

Bit :	7	6	5	4	3	2	1	0
	0	MD	EE	FK	0	WD	WA	SF

Bit 7—Unused: Returns 0.

Bit 6—Programming Mode Related Setting Error Detect (MD): Returns the check result of whether the signal input to the FWE pin is high and whether the error protection state is entered.

When a low-level signal is input to the FWE pin or the error protection state is entered, 1 is written to this bit. The input level to the FWE pin and the error protection state can be confirmed with the FWE bit (bit 7) and the FLER bit (bit 4) in FCCS, respectively. For conditions to enter the error protection state, see section 18.6.3, Error Protection.

Bit 6

MD	Description
0	FWE and FLER settings are normal (FWE = 1, FLER = 0)
1	FWE = 0 or FLER = 1, and programming cannot be performed

Bit 5-Programming Execution Error Detect (EE): 1 is returned to this bit when the specified data could not be written because the user MAT was not erased or when flash-memory related register settings are partially changed on returning from the user branch processing.

If this bit is set to 1, there is a high possibility that the user MAT is partially rewritten. In this case, after removing the error factor, erase the user MAT.

If FMATS is set to H'AA and the user boot MAT is selected, an error occurs when programming is performed. In this case, both the user MAT and user boot MAT are not rewritten.

Programming of the user boot MAT should be performed in the boot mode or PROM mode.

Bit 5

EE	Description
0	Programming has ended normally
1	Programming has ended abnormally (programming result is not guaranteed)

Bit 4—Flash Key Register Error Detect (FK): Returns the check result of the value of FKEY before the start of the programming processing.

Bit 4

FK	Description
0	FKEY setting is normal (FKEY = H'5A)
1	FKEY setting is error (FKEY = value other than H'5A)

Bit 3—Unused: Returns 0.

Bit 2—Write Data Address Detect (WD): When flash memory area is specified as the start address of the storage destination of the program data, an error occurs.

Bit 2

WD	Description
0	Setting of write data address is normal
1	Setting of write data address is abnormal

Bit 1—Write Address Error Detect (WA): When the following area is specified as the start address of the programming destination, an error occurs.

1. If the start address is outside the flash memory area
2. If the specified address is not a 128-byte boundary (A6 to A0 are not 0)

Bit 1	
WA	**Description**
0	Setting of programming destination address is normal
1	Setting of programming destination address is abnormal

Bit 0—Success/Fail (SF): Indicates whether the program processing is ended normally or not.

Bit 0	
SF	**Description**
0	Programming is ended normally (no error)
1	Programming is ended abnormally (error occurs)

(4) Erasure Execution

When flash memory is erased, the erase-block number on the user MAT must be passed to the erasing program which is downloaded. This is set to the FEBS parameter (general register ER0).

One block is specified from the block number 0 to 15.

For details on the erasing processing procedure, see section 18.5.2, User Program Mode.

(a) Flash erase block select parameter (FEBS: general register ER0 of CPU)

This parameter specifies the erase-block number. The several block numbers cannot be specified.

Bit :	31	30	29	28	27	26	25	24
	0	0	0	0	0	0	0	0
Bit :	23	22	21	20	19	18	17	16
	0	0	0	0	0	0	0	0
Bit :	15	14	13	12	11	10	9	8
	0	0	0	0	0	0	0	0
Bit :	7	6	5	4	3	2	1	0
	EBS7	EBS6	EBS5	EBS4	EBS3	EBS2	EBS1	EBS0

Bits 31 to 8—Unused: Only 0 may be written to these bits.

Bits 7 to 0—Erase Block (EB7 to EB0): Set the erase-block number in the range from 0 to 15. 0 corresponds to the EB0 block and 15 corresponds to the EB15 block. An error occurs when the number other than 0 to 15 is set.

(b) Flash pass/fail parameter (FPFR: general register R0L of CPU)

An explanation of FPFR as the return value indicating the erase result is provided here.

Bit :	7	6	5	4	3	2	1	0
	0	MD	EE	FK	EB	0	0	SF

Bit 7—Unused: Returns 0.

Bit 6—Erasure Mode Related Setting Error Detect (MD): Returns the check result of whether the signal input to the FWE pin is high and whether the error protection state is entered.

When a low-level signal is input to the FWE pin or the error protection state is entered, 1 is written to this bit. The input level to the FWE pin and the error protection state can be confirmed with the FWE bit (bit 7) and the FLER bit (bit 4) in FCCS, respectively. For conditions to enter the error protection state, see section 18.6.3, Error Protection.

Bit 6

MD	Description
0	FWE and FLER settings are normal (FWE = 1, FLER = 0)
1	FWE = 0 or FLER = 1, and erasure cannot be performed

Bit 5—Erasure Execution Error Detect (EE): 1 is returned to this bit when the user MAT could not be erased or when flash-memory related register settings are partially changed on returning from the user branch processing.

If this bit is set to 1, there is a high possibility that the user MAT is partially erased. In this case, after removing the error factor, erase the user MAT.

If FMATS is set to H'AA and the user boot MAT is selected, an error occurs when erasure is performed. In this case, both the user MAT and user boot MAT are not erased.

Erasing of the user boot MAT should be performed in the boot mode or PROM mode.

Bit 5

EE	Description
0	Erasure has ended normally
1	Erasure has ended abnormally (erasure result is not guaranteed)

Bit 4—Flash Key Register Error Detect (FK): Returns the check result of FKEY value before start of the erasing processing.

Bit 4	
FK	**Description**
0	FKEY setting is normal (FKEY = H'5A)
1	FKEY setting is error (FKEY = value other than H'5A)

Bit 3—Erase Block Select Error Detect (EB): Returns the check result whether the specified erase-block number is in the block range of the user MAT.

Bit 3	
EB	**Description**
0	Setting of erase-block number is normal
1	Setting of erase-block number is abnormal

Bits 2 to 1—Unused: Return 0.

Bit 0—Success/Fail (SF): Indicates whether the erasing processing is ended normally or not.

Bit 0	
SF	**Description**
0	Erasure is ended normally (no error)
1	Erasure is ended abnormally (error occurs)

18.4.4 RAM Control Register (RAMCR)

When the realtime programming of the user MAT is emulated, RAMCR sets the area of the user MAT which is overlapped with a part of the on-chip RAM. RAMCR is initialized to H'F0 at a power-on reset or in hardware standby mode and is not initialized in software standby mode. The RAMCR setting must be executed in user mode or in user program mode.

For the division method of the user-MAT area, see table 18.7. In order to operate the emulation function certainly, the target MAT of the RAM emulation must not be accessed immediately after RAMCR is programmed. If it is accessed, the normal access is not guaranteed.

Bit :	7	6	5	4	3	2	1	0
	—	—	—	—	RAMS	RAM2	RAM1	RAM0
Initial value :	1	1	1	1	0	0	0	0
R/W :	R	R	R	R	R/W	R/W	R/W	R/W

Bits 7 to 4—Reserved: These bits are always read as 1. The write value should always be 1.

Bit 3—RAM Select (RAMS): Sets whether the user MAT is emulated or not. When RAMS = 1, all blocks of the user MAT are in the programming/erasing protection state.

Bit 3		
RAMS	**Description**	
0	Emulation is not selected Programming/erasing protection of all user-MAT blocks is invalid	(Initial value)
1	Emulation is selected Programming/erasing protection of all user-MAT blocks is valid	

Bits 2 to 0—User MAT Area Select: These bits are used with bit 3 and select the user-MAT area to be overlapped with the on-chip RAM (see table 18.7).

Table 18.7 Division of User MAT Area

RAM Area	Block Name	RAMS	RAM2	RAM1	RAM0
H'FFE000 to H'FFEFFF	RAM area (4 kbytes)	0	*	*	*
H'000000 to H'000FFF	EB0 (4kbytes)	1	0	0	0
H'001000 to H'001FFF	EB1 (4kbytes)	1	0	0	1
H'002000 to H'002FFF	EB2 (4kbytes)	1	0	1	0
H'003000 to H'003FFF	EB3 (4kbytes)	1	0	1	1
H'004000 to H'004FFF	EB4 (4kbytes)	1	1	0	0
H'005000 to H'005FFF	EB5 (4kbytes)	1	1	0	1
H'006000 to H'006FFF	EB6 (4kbytes)	1	1	1	0
H'007000 to H'007FFF	EB7 (4kbytes)	1	1	1	1

Note: * Don't care.

18.4.5 Flash Vector Address Control Register (FVACR)

FVACR modifies the space which reads the vector table data of the NMI interrupts. Normally the vector table data is read from the address spaces from H'00001C to H'00004F. However, the vector table can be read from the internal I/O register (FVADRR to FVADRL) by the FVACR setting. FVACR is initialized to H'00 at a power-on reset or in hardware standby mode.

All interrupts including NMI must be prohibited in the programming/erasing processing or during downloading on-chip program. When if it is not possible to avoid using the NMI interrupt due to system requirements, such as during system error processing, FVACR and FVADRR to FVADRL must be set and the interrupt exception processing routine must be set in the on-chip RAM.

Bit :	7	6	5	4	3	2	1	0
	FVCHGE	—	—	—	FVSEL3	FVSEL2	FVSEL1	FVSEL0
Initial value :	0	0	0	0	0	0	0	0
R/W :	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Bit 7—Vector Switch Function Valid (FVCHGE): Selects whether the function for modifying the space which reads the vector table data is valid or invalid. When FVCHGE = 1, the vector table data can be read from the internal I/O registers (FVADRR to FVADRL).

Bit 7

FVCHGE	Description
0	Function for modifying the space which reads the vector table data is invalid (Initial value)
1	Function for modifying the space which reads the vector table data is valid

Bits 6 to 4—Reserved: These bits are always read as 0. The write value should always be 0.

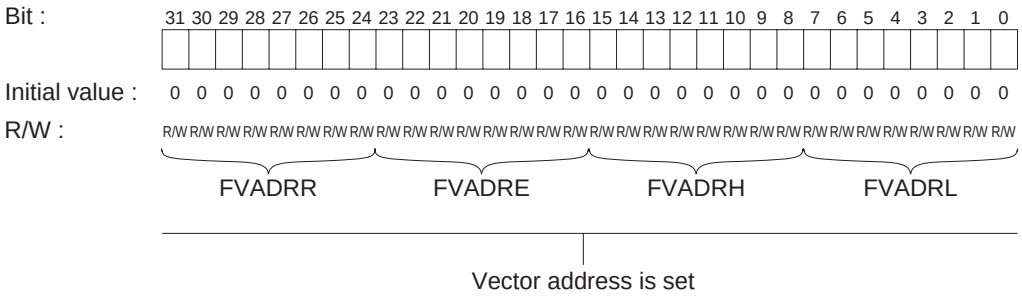
Bits 3 to 0—Interrupt Source Select (FVSEL3 to FVSEL0): The vector table of the NMI interrupt processing can be in the internal I/O registers (FVADRR to FVADRL) by setting this bit.

Interrupt Source Bits

Bit 3	Bit 2	Bit 1	Bit 0	
FVSEL3	FVSEL2	FVSEL1	FVSEL0	Function
0	0	0	0	Vector table data is in area 0 (Initial value) (H'00001C to H'00004F)
0	0	0	1	Setting prohibited
0	0	1	—	
0	1	—	—	
1	0	0	0	Vector table data is in internal I/O register (FVADRR to FVADRL)
1	0	0	1	Setting prohibited
1	0	1	—	
1	1	—	—	

18.4.6 Flash Vector Address Data Register (FVADR)

When the function for switching the space which reads the vector table data by using FVACR is valid, FVADR stores the vector data. FVADR is configured by the four 8-bit registers (FVADRR, FVADRE, FVADRH, and FVADRL). FVADR is initialized to H'00000000 at a power-on reset or in hardware standby mode.



18.5 On-Board Programming Mode

When the pin is set in on-board programming mode and the reset start is executed, the on-board programming state that can program/erase the on-chip flash memory is entered. On-board programming mode has three operating modes: user programming mode, user boot mode, and boot mode.

For details on the pin setting for entering each mode, see table 18.1. For details on the state transition of each mode for flash memory, see figure 18.2.

18.5.1 Boot Mode

Boot mode executes programming/erasing user MAT and user boot MAT by means of the control command and program data transmitted from the host using the on-chip SCI. The tool for transmitting the control command and program data must be prepared in the host. The SCI communication mode is set to asynchronous mode. When reset start is executed after this LSI's pin is set in boot mode, the boot program in the microcomputer is initiated. After the SCI bit rate is automatically adjusted, the communication with the host is executed by means of the control command method.

The system configuration diagram in boot mode is shown in figure 18.6. For details on the pin setting in boot mode, see table 18.1. The NMI and other interrupts are ignored in boot mode.

Make sure the NMI and other interrupts do not occur in the user system.

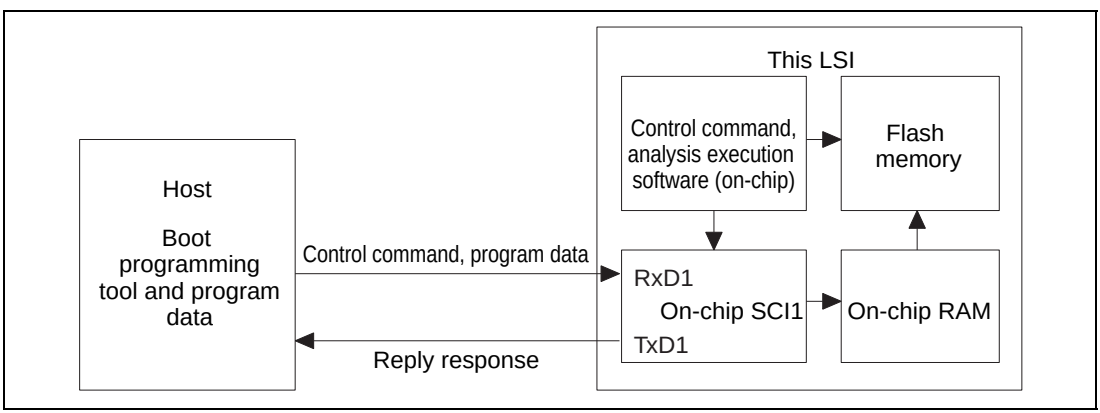


Figure 18.6 System Configuration in Boot Mode

SCI Interface Setting by Host: When boot mode is initiated, this LSI measures the low period of asynchronous SCI-communication data (H'00), which is transmitted consecutively by the host. The SCI transmit/receive format is set to 8-bit data, 1 stop bit, and no parity. This LSI calculates the bit rate of transmission by the host by means of the measured low period and transmits the bit

adjustment end sign (1 byte of H'00) to the host. The host must confirm that this bit adjustment end sign (H'00) has been received normally and transmits 1 byte of H'55 to this LSI. When reception is not executed normally, boot mode is initiated again (reset) and the operation described above must be executed. The bit rate between the host and this LSI is not matched by the bit rate of transmission by the host and system clock frequency of this LSI. To operate the SCI normally, the transfer bit rate of the host must be set to 9,600 bps or 19,200 bps.

The system clock frequency which can automatically adjust the transfer bit rate of the host and the bit rate of this LSI is shown in table 18.8. Boot mode must be initiated in the range of this system clock.

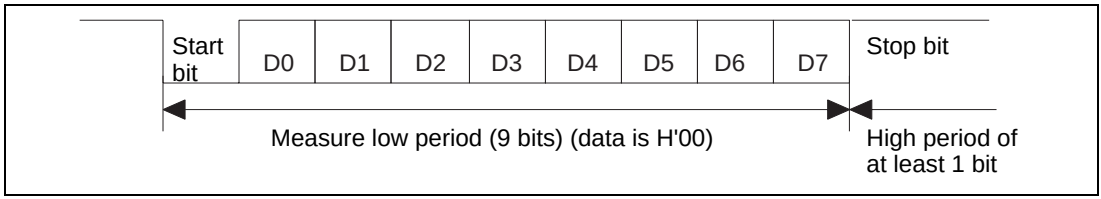


Figure 18.7 Automatic Adjustment Operation of SCI Bit Rate

Table 18.8 System Clock Frequency that Can Automatically Adjust Bit Rate of This LSI

Bit rate of host	System clock frequency which can automatically adjust bit rate of this LSI
9,600 bps	10 to 25 MHz
19,200 bps	16 to 25 MHz

State Transition: The overview of the state transition after boot mode is initiated is shown in figure 18.8. For details on boot mode, refer to section 18.10.1, Serial Communications Interface Specification for Boot Mode.

1. Bit rate adjustment
   After boot mode is initiated, the bit rate of the SCI interface is adjusted with that of the host.
2. Waiting for inquiry set command
   For inquiries about user-MAT size and configuration, MAT start address, and support state, the required information is transmitted to the host.
3. Automatic erasure of all user MAT and user boot MAT
   After inquiries have finished, all user MAT and user boot MAT are automatically erased.

4. Waiting for programming/erasing command

   • When the program preparation notice is received, the state for waiting program data is entered. The programming start address and program data must be transmitted following the programming command. When programming is finished, the programming start address must be set to H'FFFFFFFF and transmitted. Then the state for waiting program data is returned to the state of programming/erasing command wait.

   • When the erasure preparation notice is received, the state for waiting erase-block data is entered. The erase-block number must be transmitted following the erasing command. When the erasure is finished, the erase-block number must be set to H'FF and transmitted. Then the state for waiting erase-block data is returned to the state for waiting programming/erasing command. The erasure must be executed when reset start is not executed and the specified block is programmed after programming is executed in boot mode. When programming can be executed by only one operation, all blocks are erased before the state for waiting programming/erasing/other command is entered. The erasing operation is not required.

   • There are many commands other than programming/erasing. Examples are sum check, blank check (erasure check), and memory read of the user MAT/user boot MAT and acquisition of current status information.

Note that memory read of the user MAT/user boot MAT can only read the program data after all user MAT/user boot MAT has automatically been erased.

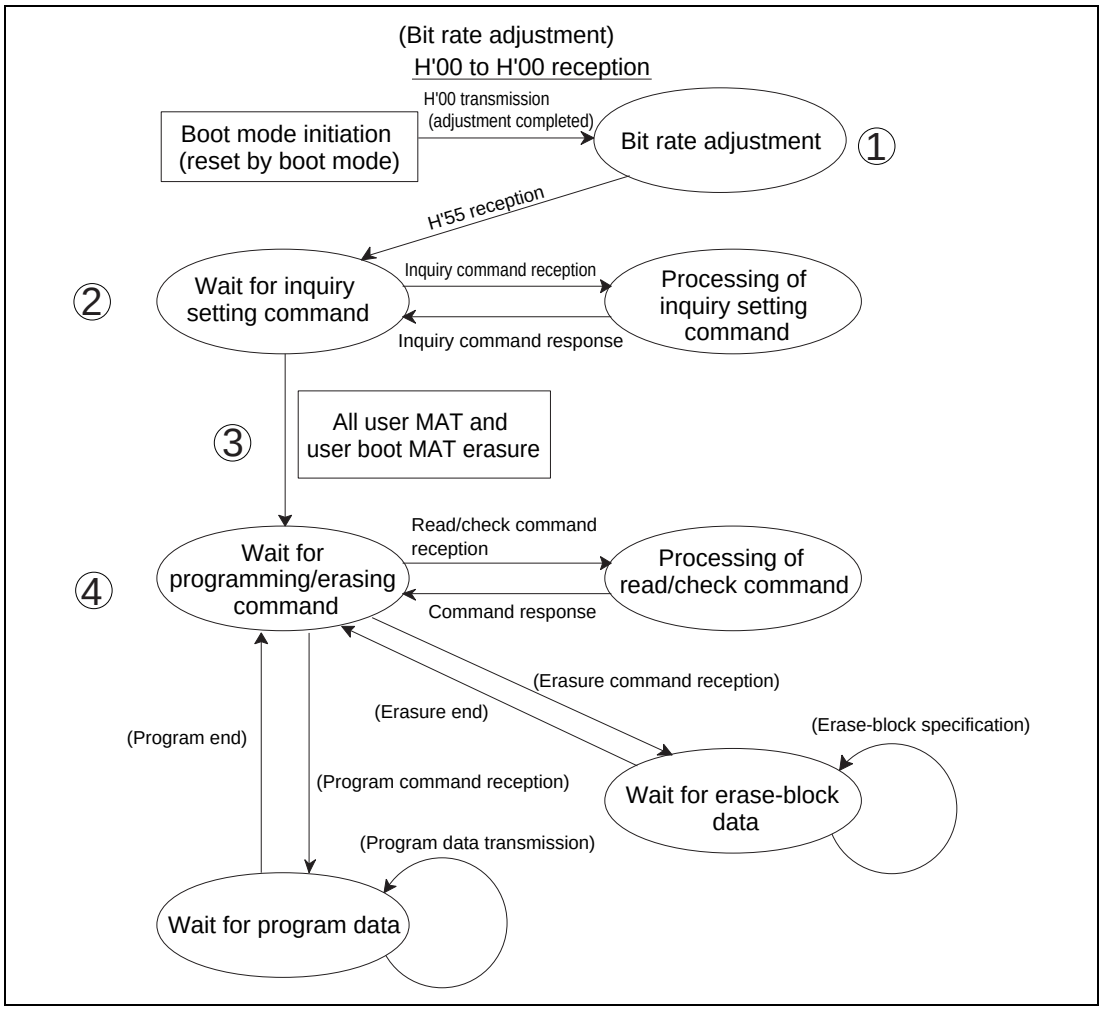


Figure 18.8 Overview of Boot Mode State Transition

18.5.2 User Program Mode

The user MAT can be programmed/erased in user program mode. (The user boot MAT cannot be programmed/erased.)

Programming/erasing is executed by downloading the program in the microcomputer.

The overview flow is shown in figure 18.9.

High voltage is applied to internal flash memory during the programming/erasing processing. Therefore, transition to reset or hardware standby must not be executed. Doing so may cause

damage or destroy flash memory. If reset is executed accidentally, reset must be released after the reset input period, which is longer than normal 100 µs.

For information on the programming procedure refer to “Programming Procedure in User Program Mode”, and for information on the erasing procedure refer to “Erasing Procedure in User Program Mode”, below.

For the overview of a processing that repeats erasing and programming by downloading the programming program and the erasing program in separate on-chip ROM areas using FTDAR, see “Erasing and Programming Procedure in User Program Mode” which appears later in this section.

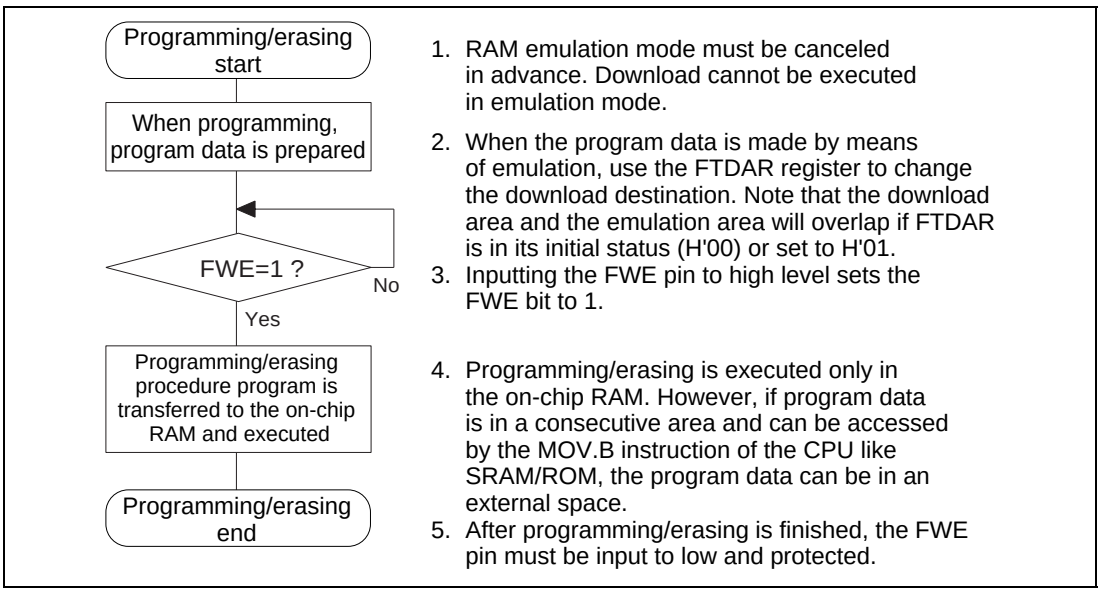


Figure 18.9 Programming/Erasing Overview Flow

On-chip RAM Address Map when Programming/Erasing is Executed: Parts of the procedure program that are made by the user, like download request, programming/erasing procedure, and judgement of the result, must be executed in the on-chip RAM. The on-chip program that is to be downloaded is all in the on-chip RAM. Note that area in the on-chip RAM must be controlled so that these parts do not overlap.

Figure 18.10 shows the program area to be downloaded.

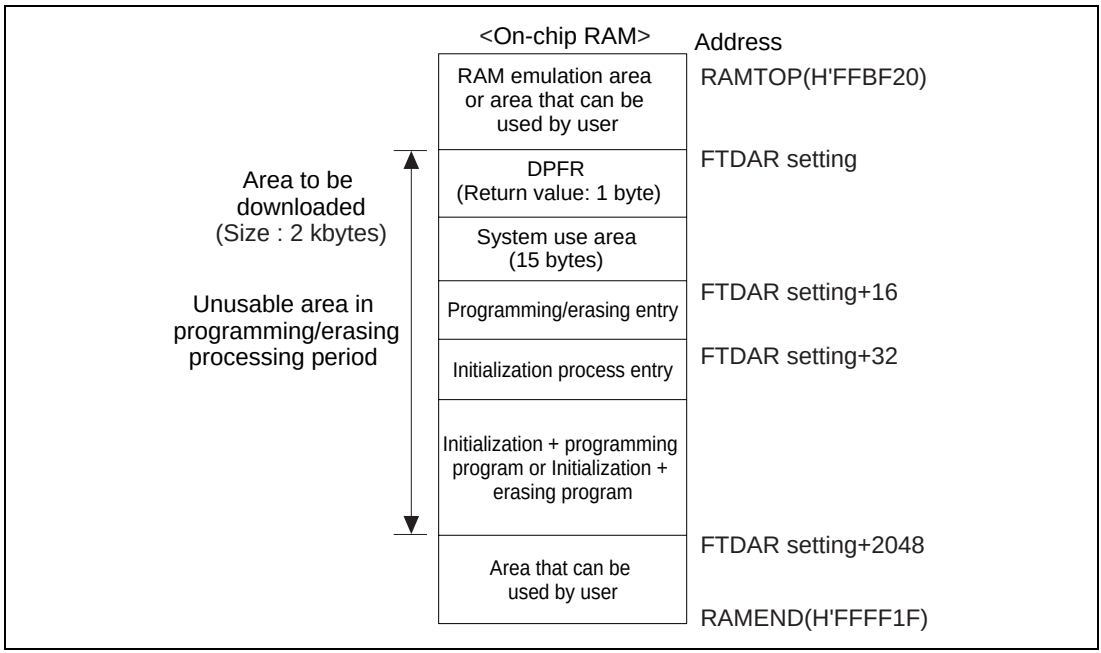


Figure 18.10 RAM Map when Programming/Erasing is Executed

Programming Procedure in User Program Mode: The procedures for download, initialization, and programming are shown in figure 18.11.

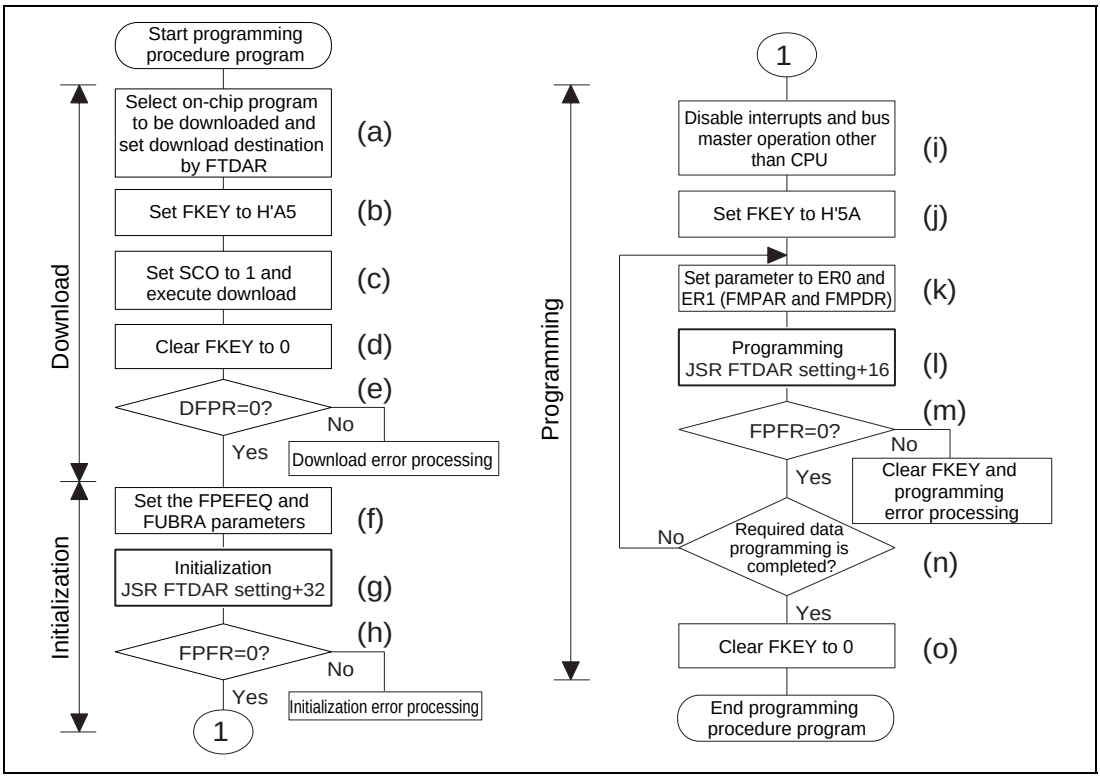


Figure 18.11 Programming Procedure

The details of the programming procedure are described below. The procedure program must be executed in an area other than the flash memory to be programmed. Especially the part where the SCO bit in FCCS is set to 1 for downloading must be executed in the on-chip RAM.

The area that can be executed in the steps of the user procedure program (on-chip RAM, user MAT, and external space) is shown in section 18.10.3, Procedure Program and Storable Area for Programming Data.

The following description assumes the area to be programmed on the user MAT is erased and program data is prepared in the consecutive area. When erasing is not executed, erasing is executed before writing.

128-byte programming is performed in one program processing. When more than 128-byte programming is performed, programming destination address/program data parameter is updated in 128-byte units and programming is repeated.

When less than 128-byte programming is performed, data must total 128 bytes by adding the invalid data. If the invalid data to be added is H'FF, the program processing period can be shorted.

(a) Select the on-chip program to be downloaded and the download destination.

When the PPVS bit of FPCS is set to 1, the programming program is selected.
Several programming/erasing programs cannot be selected at one time. If several programs are set, download is not performed and a download error is returned to the source select error detect (SS) bit in the DPFR parameter.
Specify the start address of the download destination by FTDAR.

(b) Program H'A5 in FKEY

If H'A5 is not written to FKEY for protection, 1 cannot be written to the SCO bit for download request.

(c) 1 is written to the SCO bit of FCCS and then download is executed.

To write 1 to the SCO bit, the following conditions must be satisfied.

- RAM emulation mode is canceled.
- H'A5 is written to FKEY.
- The SCO bit writing is executed in the on-chip RAM.

When the SCO bit is set to 1, download is started automatically. When the SCO bit is returned to the user procedure program, the SCO is cleared to 0. Therefore, the SCO bit cannot be confirmed to be 1 in the user procedure program.
The download result can be confirmed only by the return value of the DPFR parameter. Before the SCO bit is set to 1, incorrect judgement must be prevented by setting the DPFR parameter, that is one byte of the start address of the on-chip RAM area specified by FTDAR, to a value other than the return value (H'FF).
When download is executed, particular interrupt processing, which is accompanied by the bank switch as described below, is performed as an internal microcomputer processing. Four NOP instructions are executed immediately after the instructions that set the SCO bit to 1.

- The user-MAT space is switched to the on-chip program storage area.
- After the selection condition of the download program and the address set in FTDAR are checked, the transfer processing is executed starting from the on-chip RAM address specified by FTDAR.
- The SCO bits in FPCS, FECS, and FCCS are cleared to 0.
- The return value is set to the DPFR parameter.
- After the on-chip program storage area is returned to the user-MAT space, the user procedure program is returned.

The notes on download are as follows.

In the download processing, the values are stored in general registers than CPU.

No interrupts are accepted during download processing. However, interrupt requests other than NMI requests are held, so when processing returns to the user procedure program and interrupts are generated. NMI requests are discarded if the FVACR register value is H'00. However, if H'80 has been written to the FVACR register, they are held and the NMI interrupts are generated when processing returns to the user procedure program.

The sources of the interrupt requests from the on-chip module and at the falling edge of the IRQ are held during downloading. The refresh can be put in the DRAM.

When the level-detection interrupt requests are to be held, interrupts must be put until the download is ended.

When hardware standby mode is entered during download processing, the normal download cannot be guaranteed in the on-chip RAM. Therefore, download must be executed again.

Since a stack area of a maximum 128 bytes is used, the area must be saved before setting the SCO bit to 1.

If flash memory is accessed by the DMAC or $\overline{\text{BREQ}}$ during downloading, the operation cannot be guaranteed. Therefore, access by the DMAC or $\overline{\text{BREQ}}$ must not be executed.

(d) FKEY is cleared to H'00 for protection.

(e) The value of the DPFR parameter must be checked and the download result must be confirmed.

A recommended procedure for confirming the download result is shown below.

- Check the value of the DPFR parameter (one byte of start address of the download destination specified by FTDAR). If the value is H'00, download has been performed normally. If the value is not H'00, the source that caused download to fail can be investigated by the description below.
- If the value of the DPFR parameter is the same as before downloading (e.g. H'FF), the address setting of the download destination in FTDAR may be abnormal. In this case, confirm the setting of the TDER bit (bit 7) in FTDAR.
- If the value of the DPFR parameter is different from before downloading, check the SS bit (bit 2) and the FK bit (bit 1) in the DPFR parameter to ensure that the download program selection and FKEY register setting were normal, respectively.

(f) The operating frequency and user branch destination are set to the FPEFEQ and FUBRA parameters for initialization.

- The current frequency of the CPU clock is set to the FPEFEQ parameter (general register: ER0).

For the settable range of the FPEFEQ parameter, see section 21.4.1, Clock Timing. When the frequency is set out of this range, an error is returned to the FPFR parameter of the initialization program and initialization is not performed. For details on the frequency setting, see the description in 18.4.3(2) (a) Flash programming/erasing frequency parameter (FPEFEQ: general register ER0 of CPU).

- The start address in the user branch destination is set to the FUBRA parameter (general register: ER1).

  Not available in the H8/3069R, 0 must be set to FUBRA.
  When the user branch is executed, the branch destination is executed in a user MAT other than the one that is to be programmed. The area of the on-chip program that is downloaded cannot be set.
  The program processing must be returned from the user branch processing by the RTS instruction.
  See the description in 18.4.3 (2) (b) Flash user branch address setting parameter (FUBRA: general register ER1 of CPU).

(g) Initialization

When a programming program is downloaded, the initialization program is also downloaded to the on-chip RAM. There is an entry point of the initialization program in the area from (download start address set by FTDAR) + 32 bytes. The subroutine is called and initialization is executed by using the following steps.

```
MOV.L   #DLTOP+32,ER2       ; Set entry address to ER2
JSR     @ER2                ; Call initialization routine
NOP
```

- The general registers other than R0L are saved in the initialization program.
- R0L is a return value of the FPFR parameter.
- Since the stack area is used in the initialization program, a stack area of a maximum 128 bytes must be saved in RAM.
- Interrupts can be accepted during the execution of the initialization program. The program storage area and stack area in the on-chip RAM and register values must not be destroyed.

(h) The return value in the initialization program, FPFR (general register R0L) is judged.

(i) All interrupts and the use of a bus master other than the CPU are prohibited.

The specified voltage is applied for the specified time when programming or erasing. If interrupts occur or the bus mastership is moved to other than the CPU during this time, more than the specified voltage will be applied and flash memory may be damaged. Therefore, interrupts and movement of bus mastership to DMAC or $\overline{\text{BREQ}}$ and DRAM refresh other than the CPU are prohibited.

The interrupt processing prohibition is set up by setting the bit 7 (I) in the condition code register (CCR) of the CPU to b'1. Then interrupts other than NMI are held and are not executed.

The NMI interrupts must not occur in the user system.

The interrupts that are held must be processed in executed after all program processing.

When the bus mastership is moved to DMAC or $\overline{\text{BREQ}}$ or DRAM refresh except for the CPU, the error protection state is entered. Therefore, reservation of bus mastership by DMAC or $\overline{\text{BREQ}}$ is prohibited.

(j) FKEY must be set to H'5A and the user MAT must be prepared for programming.

(k) The parameter which is required for programming is set.

The start address of the programming destination of the user MAT (FMPAR) is set to general register ER1. The start address of the program data storage area (FMPDR) is set to general register ER0.

- Example of the FMPAR setting

  FMPAR specifies the programming destination address. When an address other than one in the user MAT area is specified, even if the programming program is executed, programming is not executed and an error is returned to the return value parameter FPFR. Since the unit is 128 bytes, the lower eight bits (A7 to A0) must be in the 128-byte boundary of H'00 or H'80.
- Example of the FMPDR setting

  When the storage destination of the program data is flash memory, even if the program execution routine is executed, programming is not executed and an error is returned to the FPFR parameter. In this case, the program data must be transferred to the on-chip RAM and then programming must be executed.

(l) Programming

There is an entry point of the programming program in the area from (download start address set by FTDAR) + 16 bytes of on-chip RAM. The subroutine is called and programming is executed by using the following steps.

```
MOV.L   #DLTOP+16,ER2       ; Set entry address to ER2
JSR     @ER2                ; Call programming routine
NOP
```

- The general registers other than R0L are saved in the programming program.
- R0 is a return value of the FPFR parameter.

- Since the stack area is used in the programming program, a stack area of a maximum 128 bytes must be reserved in RAM

(m) The return value in the programming program, FPFR (general register R0L) is judged.

(n) Determine whether programming of the necessary data has finished.

If more than 128 bytes of data are to be programmed, specify FMPAR and FMPDR in 128-byte units, and repeat steps (l) to (m). Increment the programming destination address by 128 bytes and update the programming data pointer correctly. If an address which has already been programmed is written to again, not only will a programming error occur, but also flash memory will be damaged.

(o) After programming finishes, clear FKEY and specify software protection.

If this LSI is restarted by a power-on reset immediately after user MAT programming has finished, secure a reset period (period of $\overline{RES}$ = 0) that is at least as long as normal 100 µs.

Erasing Procedure in User Program Mode: The procedures for download, initialization, and erasing are shown in figure 18.12.

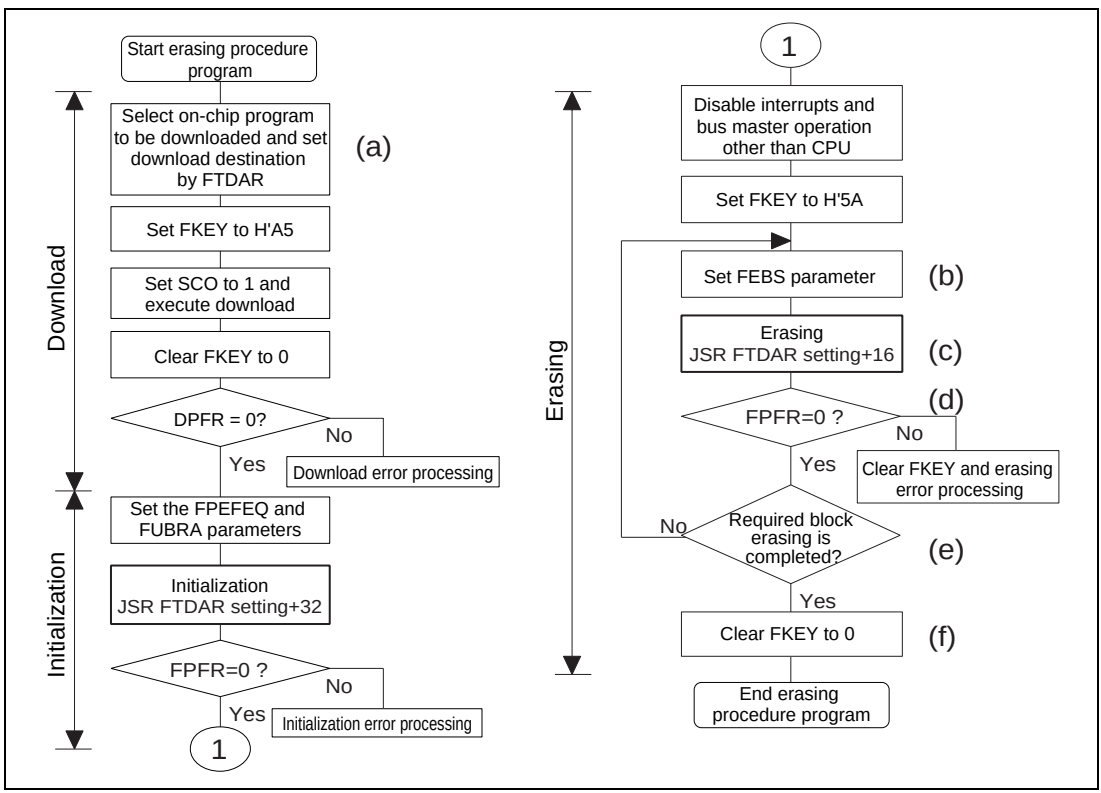


Figure 18.12 Erasing Procedure

The details of the erasing procedure are described below. The procedure program must be executed in an area other than the user MAT to be erased. Especially the part where the SCO bit in FCCS is set to 1 for downloading must be executed in on-chip RAM.

The area that can be executed in the steps of the user procedure program (on-chip RAM, user MAT, and external space) is shown in section 18.10.3, Procedure Program and Storable Area for Programming Data.

For the downloaded on-chip program area, refer to the RAM map for programming/erasing in figure 18.10, RAM Map when Programming/Erasing is Executed.

A single divided block is erased by one erasing processing. For block divisions, refer to figure 18.4, Block Division of User MAT. To erase two or more blocks, update the erase block number and perform the erasing processing for each block.

(a) Select the on-chip program to be downloaded

Set the EPVB bit in FECS to 1.

Several programming/erasing programs cannot be selected at one time. If several programs are set, download is not performed and a download error is returned to the source select error detect (SS) bit in the DPFR parameter.

The procedures to be carried out after setting FKEY, e.g. download and initialization, are the same as those in the programming procedure. For details, refer to Programming Procedure in User Program Mode in section 18.5.2.

(b) Set the FEBS parameter necessary for erasure

Set the erase block number of the user MAT in the flash erase block select parameter FEBS (general register ER0). If a value other than an erase block number of the user MAT is set, no block is erased even though the erasing program is executed, and an error is returned to the return value parameter FPFR.

(c) Erasure

Similar to as in programming, there is an entry point of the erasing program in the area from (download start address set by FTDAR) + 16 bytes of on-chip RAM. The subroutine is called and erasing is executed by using the following steps.

```
MOV.L   #DLTOP+16,ER2       ; Set entry address to ER2
JSR     @ER2                ; Call erasing routine
NOP
```

- The general registers other than R0L are saved in the erasing program.
- R0 is a return value of the FPFR parameter.
- Since the stack area is used in the erasing program, a stack area of a maximum 128 bytes must be reserved in RAM

(d) The return value in the erasing program, FPFR (general register R0L) is judged.

(e) Determine whether erasure of the necessary blocks has finished.

If more than one block is to be erased, update the FEBS parameter and repeat steps (b) and (c). Blocks that have already been erased can be erased again.

(f) After erasure finishes, clear FKEY and specify software protection.

If this LSI is restarted by a power-on reset immediately after user MAT erasure has finished, secure a reset period (period of $\overline{RES}$ = 0) that is at least as long as normal 100 µs.

(4) Erasing and Programming Procedure in User Program Mode

By changing the on-chip RAM address of the download destination in FTDAR, the erasing program and programming program can be downloaded to separate on-chip RAM areas.

Figure 18.13 shows an example of repetitively executing RAM emulation, erasing, and programming.

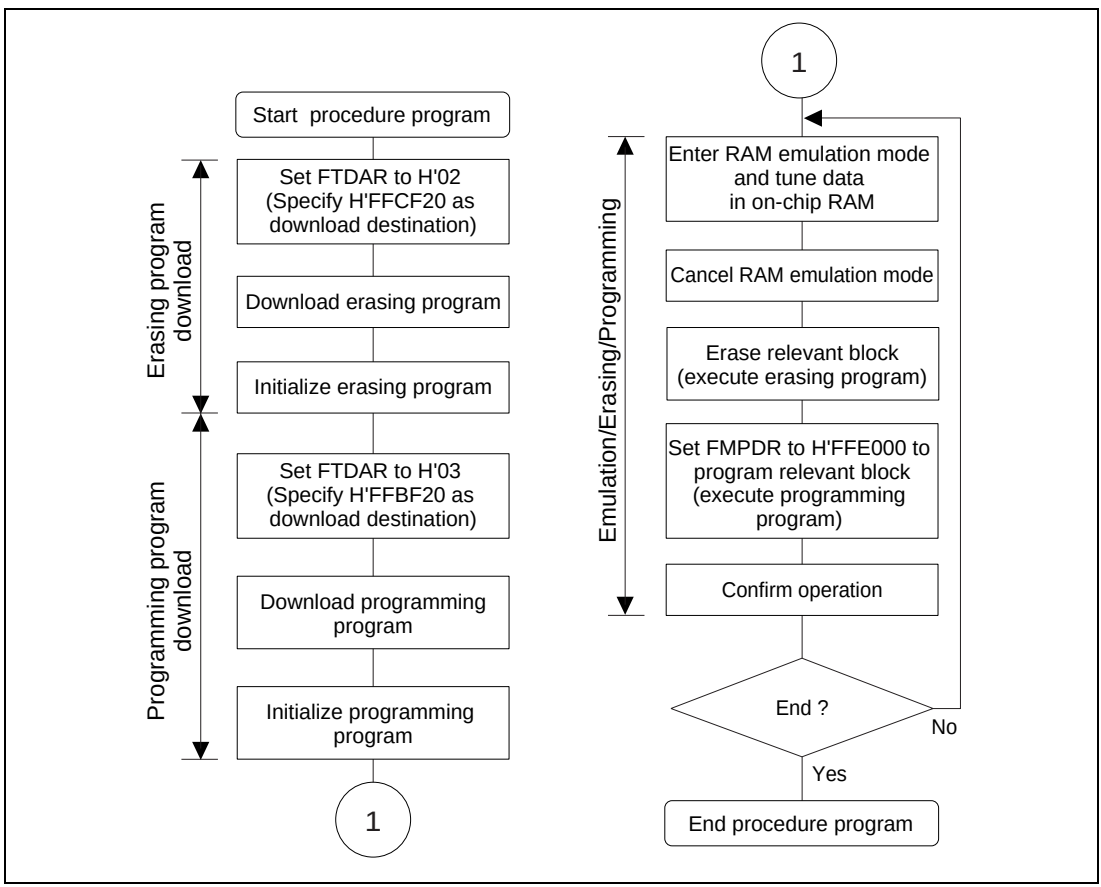


Figure 18.13 Sample Procedure of Repeating RAM Emulation, Erasing, and Programming (Overview)

In the above example, the erasing program and programming program are downloaded to areas excluding the 4 kbytes (H'FFE000 to H'FFEFFF) from the start of on-chip ROM.

Download and initialization are performed only once at the beginning.

In this kind of operation, note the following:

- Be careful not to damage on-chip RAM with overlapped settings.
  In addition to the RAM emulation area, erasing program area, and programming program area, areas for the user procedure programs, work area, and stack area are reserved in on-chip RAM. Do not make settings that will overwrite data in these areas.
- Be sure to initialize both the erasing program and programming program.
  Initialization by setting the FPEFEQ and FUBRA parameters must be performed for both the erasing program and the programming program. Initialization must be executed for both entry addresses: (download start address for erasing program) + 32 bytes (H'FFCF40 in this example) and (download start address for programming program) + 32 bytes (H'FFBF40 in this example).

18.5.3 User Boot Mode

This LSI has user boot mode which is initiated with different mode pin settings than those in user program mode or boot mode. User boot mode is a user-arbitrary boot mode, unlike boot mode that uses the on-chip SCI.

Only the user MAT can be programmed/erased in user boot mode. Programming/erasing of the user boot MAT is only enabled in boot mode or programmer mode.

User Boot Mode Initiation: For the mode pin settings to start up user boot mode, see table 18.1.

When the reset start is executed in user boot mode, the built-in check routine runs. The user MAT and user boot MAT states are checked by this check routine.

While the check routine is running, NMI and all other interrupts cannot be accepted.

Next, processing starts from the execution start address of the reset vector in the user boot MAT. At this point, H'AA is set to the flash MAT select register FMATS because the execution MAT is the user boot MAT.

To enable NMI interrupts in a user boot MAT program, after the reset ends ($\overline{RES}$ = 1) and 400 µs passes, set NMI to 1.

User MAT Programming in User Boot Mode: For programming the user MAT in user boot mode, additional processings made by setting FMATS are required: switching from user-boot-MAT selection state to user-MAT selection state, and switching back to user-boot-MAT selection state after programming completes.

Figure 18.14 shows the procedure for programming the user MAT in user boot mode.

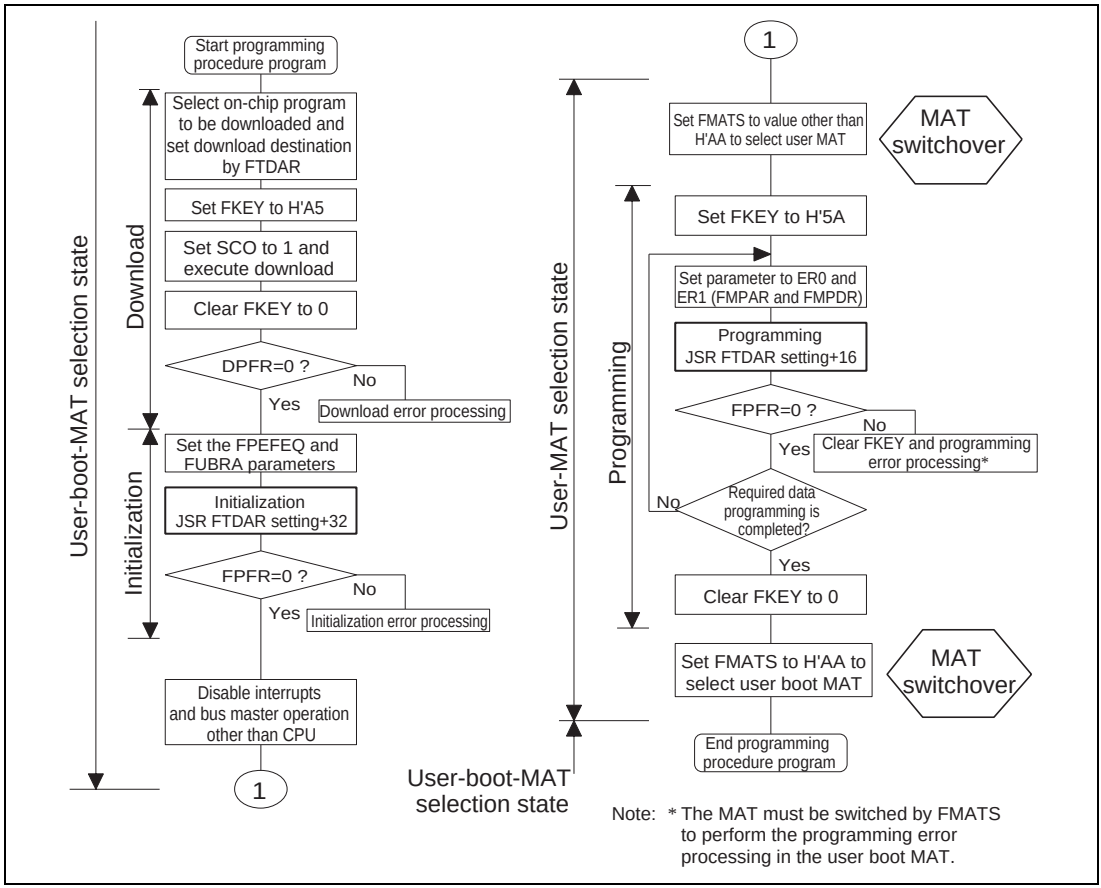


Figure 18.14 Procedure for Programming User MAT in User Boot Mode

The difference between the programming procedures in user program mode and user boot mode is whether the MAT is switched or not as shown in figure 18.14.

In user boot mode, the user boot MAT can be seen in the flash memory space with the user MAT hidden in the background. The user MAT and user boot MAT are switched only while the user MAT is being programmed. Because the user boot MAT is hidden while the user MAT is being programmed, the procedure program must be located in an area other than flash memory. After programming finishes, switch the MATs again to return to the first state.

MAT switchover is enabled by writing a specific value to FMATS. However note that while the MATs are being switched, the LSI is in an unstable state, e.g. access to a MAT is not allowed until MAT switching is completely finished, and if an interrupt occurs, from which MAT the interrupt vector is read from is undetermined. Perform MAT switching in accordance with the description in section 18.8, Switching between User MAT and User Boot MAT.

Except for MAT switching, the programming procedure is the same as that in user program mode.

The area that can be executed in the steps of the user procedure program (on-chip RAM, user MAT, and external space) is shown in section 18.10.3, Procedure Program and Storable Area for Programming Data.

User MAT Erasing in User Boot Mode: For erasing the user MAT in user boot mode, additional processings made by setting FMATS are required: switching from user-boot-MAT selection state to user-MAT selection state, and switching back to user-boot-MAT selection state after erasing completes.

Figure 18.15 shows the procedure for erasing the user MAT in user boot mode.

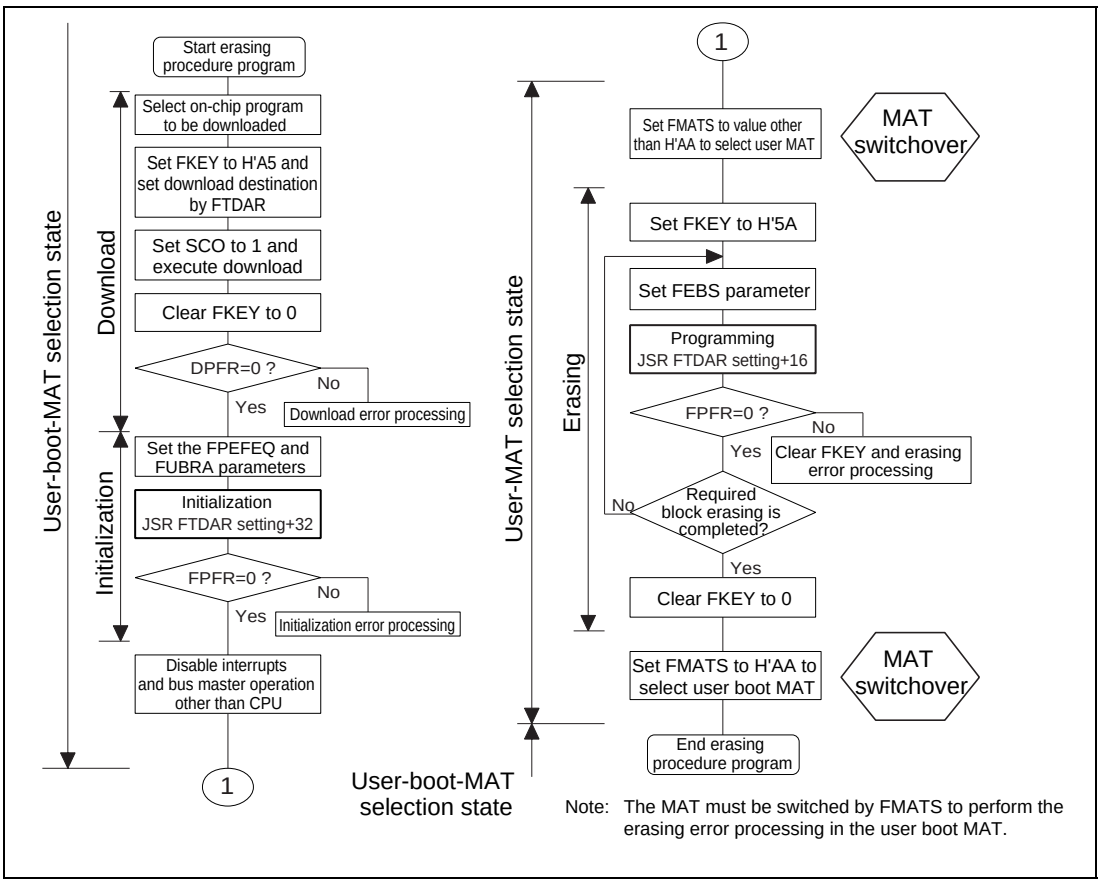


Figure 18.15 Procedure for Erasing User MAT in User Boot Mode

The difference between the erasing procedures in user program mode and user boot mode depends on whether the MAT is switched or not as shown in figure 18.15.

MAT switching is enabled by writing a specific value to FMATS. However note that while the MATs are being switched, the LSI is in an unstable state, e.g. access to a MAT is not allowed until MAT switching is completed finished, and if an interrupt occurs, from which MAT the interrupt vector is read from is undetermined. Perform MAT switching in accordance with the description in section 18.8, Switching between User MAT and User Boot MAT.

Except for MAT switching, the erasing procedure is the same as that in user program mode.

The area that can be executed in the steps of the user procedure program (on-chip RAM, user MAT, and external space) is shown in section 18.10.3, Procedure Program and Storable Area for Programming Data.

18.6 Protection

There are two kinds of flash memory program/erase protection: hardware and software protection.

18.6.1 Hardware Protection

Programming and erasing of flash memory is forcibly disabled or suspended by hardware protection. In this state, the downloading of an on-chip program and initialization of the flash memory are possible. However, an activated program for programming or erasure cannot program or erase locations in a user MAT, and the error in programming/erasing is reported in the parameter FPFR.

Table 18.9 Hardware Protection

Item	Description	Function to be Protected	
		Download	Program/Erase
FWE-pin protection	• The input of a low-level signal on the FWE pin clears the FWE bit of FCCS and the device enters a program/erase-protected state.	—	○
Reset/standby protection	• A power-on reset (including a power-on reset by the WDT) and entry to standby mode reinitialize the program/erase interface register and the device enters a program/erase-protected state. • Resetting by means of the $\overline{\text{RES}}$ pin after power is initially supplied will not make the device enter the reset state unless the $\overline{\text{RES}}$ pin is held low until oscillation has stabilized. In the case of a reset during operation, hold the $\overline{\text{RES}}$ pin low for the RES pulse width that is specified in the section on AC characteristics section. If the device is reset during programming or erasure, data values in the flash memory are not guaranteed. In this case, after keeping the $\overline{\text{RES}}$ pin low for at least 100 µs, execute erasure and then execute programming again.	○	○

18.6.2 Software Protection

Software protection is set up in any of three ways: by disabling the downloading of on-chip programs for programming and erasing, by means of a key code, and by the RAM-emulation register.

Table 18.10 Software Protection

Item	Description	Function to be Protected	
		Download	Program/Erase
Protection by the SCO bit	• Clearing the SCO bit in the FCCS register makes the device enter a program/erase-protected state, and this disables the downloading of the programming/erasing programs.	○	○
Protection by the FKEY register	• Downloading and programming/erasing are disabled unless the required key code is written in the FKEY register. Different key codes are used for downloading and for programming/erasing.	○	○
Emulation protection	• Setting the RAMS bit in the RAM emulation register (RAMER) makes the device enter a program/erase-protected state.	○	○

18.6.3 Error Protection

Error protection is a mechanism for aborting programming or erasure when an error occurs, in the form of the microcomputer entering runaway during programming/erasing of the flash memory or operations that are not according to the established procedures for programming/erasing. Aborting programming or erasure in such cases prevents damage to the flash memory due to excessive programming or erasing.

If the microcomputer malfunctions during programming/erasing of the flash memory, the FLER bit in the FCCS register is set to 1 and the device enters the error-protection state, and this aborts the programming or erasure.

The FLER bit is set in the following conditions:

(1) When an interrupt, such as NMI, has occurred during programming/erasing

(2) When the relevant block area of flash memory is read during programming/erasing (including a vector read or an instruction fetch)

(3) When a SLEEP instruction (including software standby mode) is executed during programming/erasing

(4) When a bus master other than the CPU, such as DMAC or $\overline{\text{BREQ}}$, has obtained the bus right during programming/erasing

Error protection is cancelled only by a power-on reset or by hardware-standby mode. Note that the reset should only be released after providing a reset input over a period longer than the normal 100 µs period. Since high voltages are applied during programming/erasing of the flash memory, some voltage may remain after the error-protection state has been entered. For this reason, it is necessary to reduce the risk of damage to the flash memory by extending the reset period so that the charge is released.

The state-transition diagram in figure 18.16 shows transitions to and from the error-protection state.

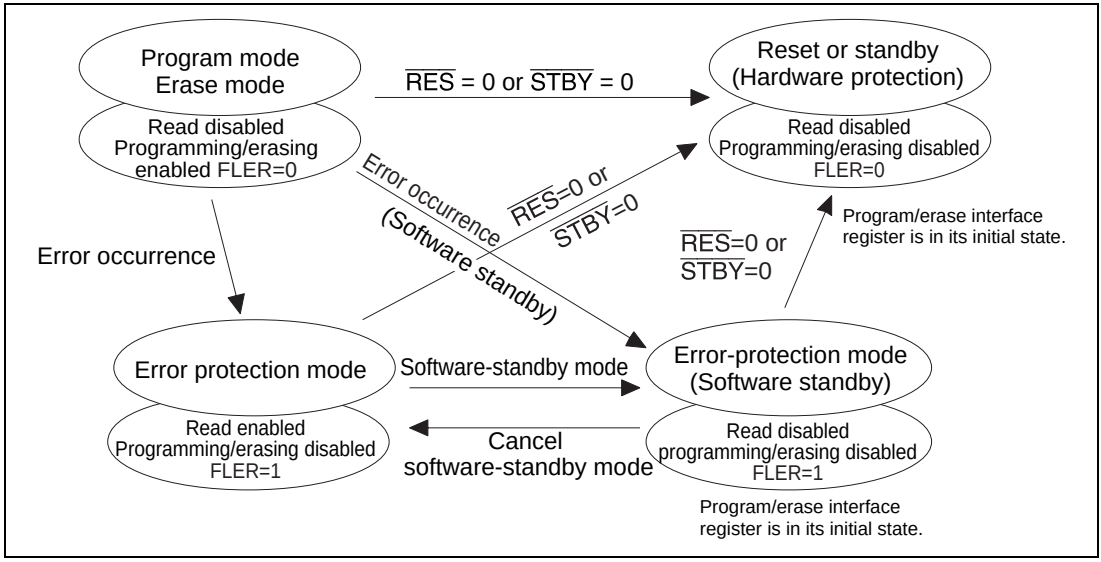


Figure 18.16 Transitions to and from the Error-Protection State

18.7 Flash Memory Emulation in RAM

To provide real-time emulation in RAM of data that is to be written to the flash memory, a part of the RAM can be overlaid on an area of flash memory (user MAT) that has been specified by the RAM control register (RAMCR). After the RAMCR setting is made, the RAM is accessible in both the user MAT area and as the RAM area that has been overlaid on the user MAT area. Such emulation is possible in both user mode and user-program mode.

Figures 18.17 and 18.18 show an example of the emulation of realtime programming of the user MAT area.

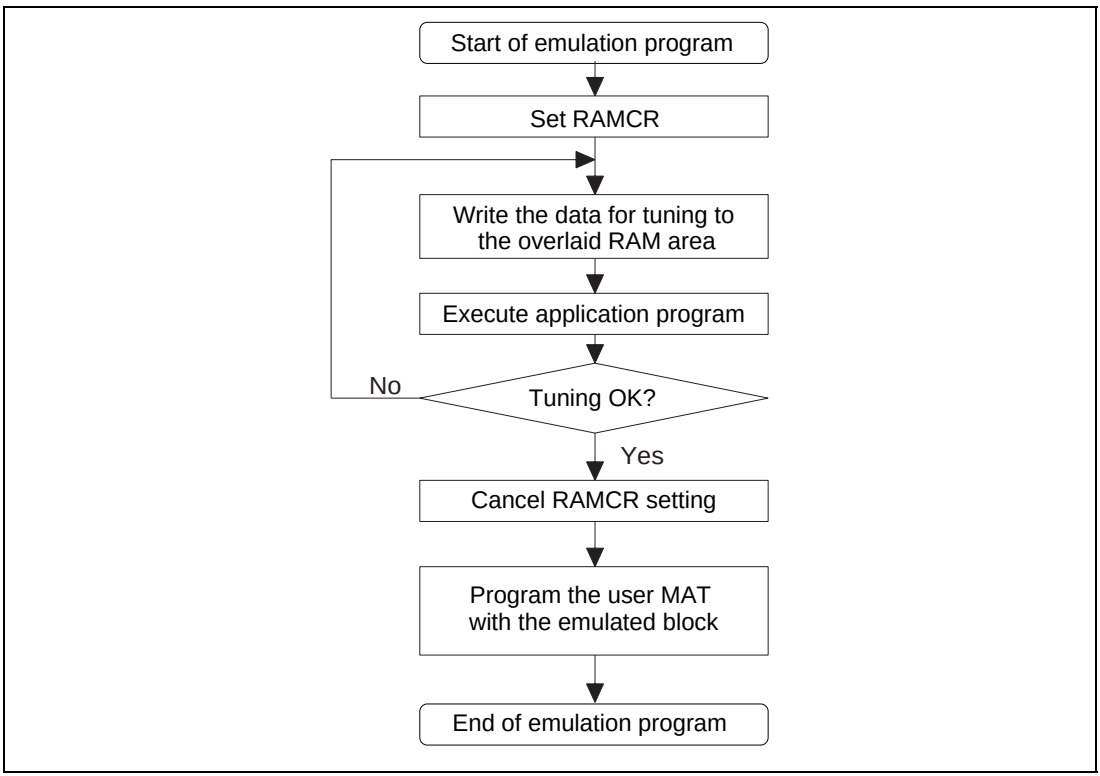


Figure 18.17 Emulation of Flash Memory in RAM

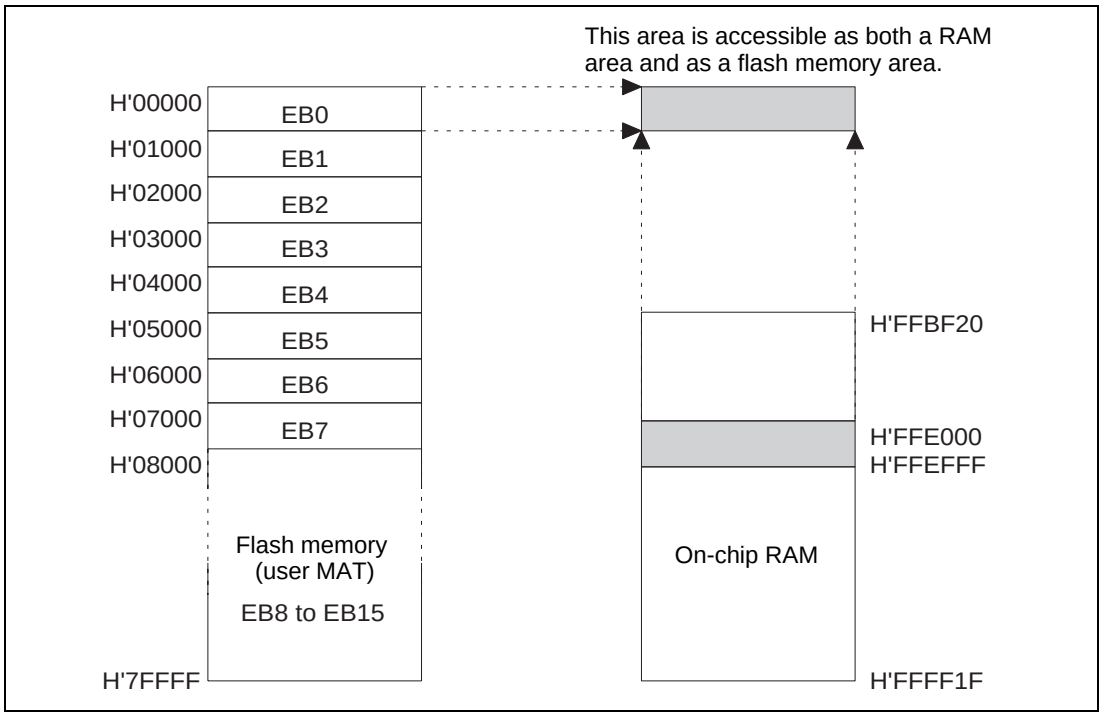


Figure 18.18 Example of a RAM-Overlap Operation

Figure 18.18 shows an example of an overlap on block area EB0 of the flash memory.

Emulation is possible for a single area selected from among the eight areas, from EB0 to EB7, of user MAT bank 0. The area is selected by the setting of the RAM2 to RAM0 bits in the RAMCR register.

(1) To overlap a part of the RAM on area EB0, to allow realtime programming of the data for this area, set the RAMCR register's RAMS bit to 1, and each of the RAM2 to RAM0 bits to 0.

(2) Realtime programming is carried out using the overlaid area of RAM.

In programming or erasing the user MAT, it is necessary to run a program that implements a series of procedural steps, including the downloading of a on-chip program. In this process, set the download area with FTDAR so that the overlaid RAM area and the area where the on-chip program is to be downloaded do not overlap. The initial setting (H'00) of FTDAR or a setting of H'01 causes part of the tuned data area to overlap with part of the download area. When using the initial setting of FTDAR, the data that is to be programmed must be saved beforehand in an area that is not used by the system.
Figure 18.19 shows an example of programming of the data, after emulation has been completed, to the EB0 area in the user MAT.

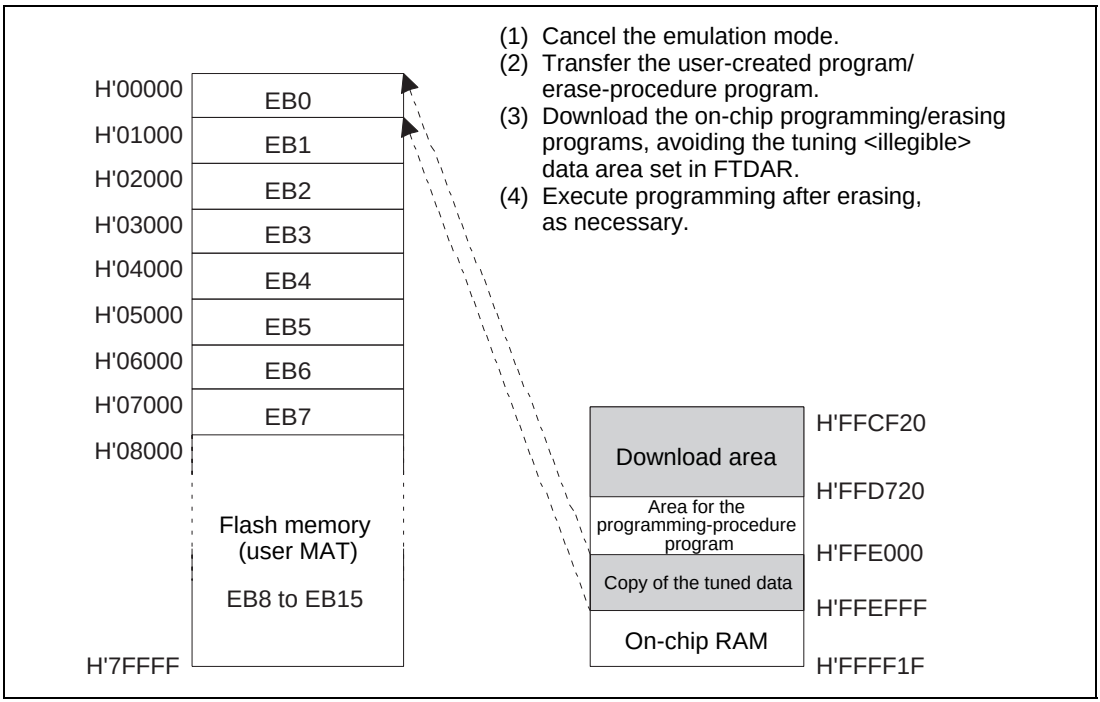


Figure 18.19 Programming of the Data After Tuning

(1) After the data to be programmed has fixed values, clear the RAMS bit to 0 to cancel the overlap of RAM.

(2) Transfer the user programming/erasing procedure program to RAM.

(3) Run the programming/erasing procedure program in RAM and download the on-chip programming/erasing program.

Specify the download start address with FTDAR so that the tuned data area does not overlap with the download area.

(4) When the EB0 area of the user MAT has not been erased, the programming program will be downloaded after erasure. Set the parameters FMPAR and FMPDR so that the tuned data is designated, and execute programming.

Note: Setting the RAMS bit to 1 puts all the blocks in the flash MAT into a program/erase-protected state regardless of the values of the RAM2 to RAM0 bits (emulation protection). In this state, downloading of the on-chip programs is also disabled, so clear the RAMS bit before actual programming or erasure.

18.8 Switching between User MAT and User Boot MAT

It is possible to alternate between the user MAT and user boot MAT. However, the following procedure is required because these MATs are allocated to address 0.
(Switching to the user boot MAT disables programming and erasing. Programming of the user boot MAT should take place in boot mode or PROM mode.)

(1) MAT switching by the FMATS register should always be executed from the on-chip RAM.
(2) To ensure that the MAT that has been switched to is accessible, execute 4 NOP instructions in the on-chip RAM immediately before or after writing to the FMATS register of the on-chip RAM (this prevents access to the flash memory during MAT switching).
(3) If an interrupt has occurred during switching, there is no guarantee of which memory MAT is being accessed. Always mask the maskable interrupts before switching between MATs. In addition, configure the system so that NMI interrupts do not occur during MAT switching.
(4) After the MATs have been switched, take care because the interrupt vector table will also have been switched. If interrupt processing is to be the same before and after MAT switching, transfer the interrupt-processing routines to the on-chip RAM, and use the settings of the FVACR and FVADR registers to place the interrupt-vector table in the on-chip RAM .
(5) Memory sizes of the user MAT and user boot MAT are different. When accessing the user boot MAT, do not access addresses above the top of its 8-kbyte memory space. If access goes beyond the 8-kbyte space, the values read are undefined.

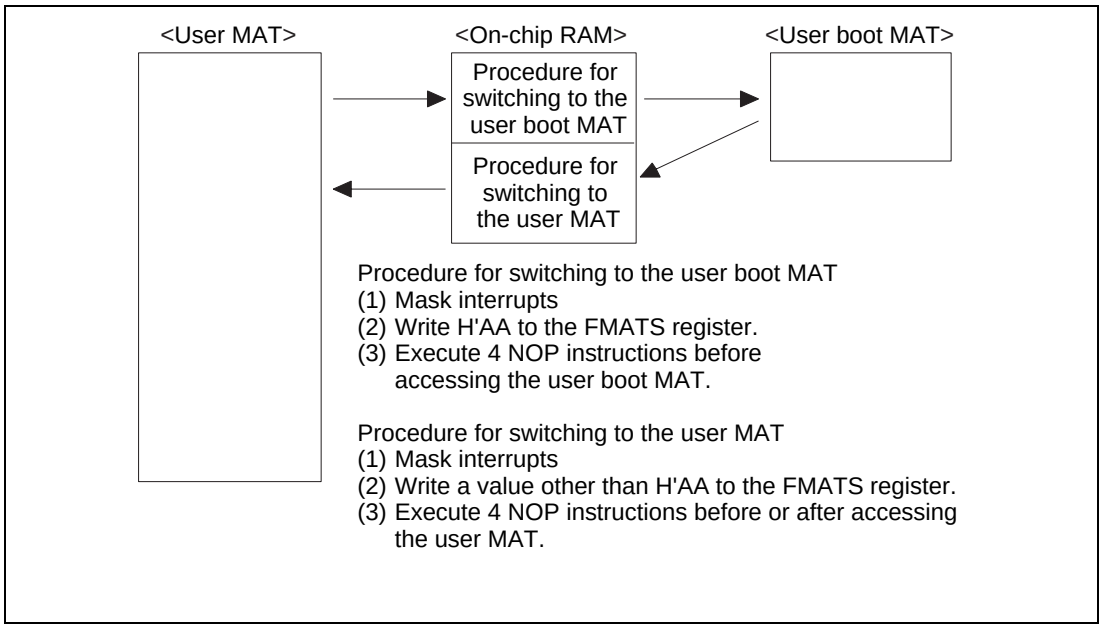


Figure 18.20 Switching between the User MAT and User Boot MAT

18.8.1 Usage Notes

1. Download time of on-chip program

   The programming program that includes the initialization routine and the erasing program that includes the initialization routine are each 2 kbytes or less. Accordingly, when the CPU clock frequency is 25 MHz, the download for each program takes approximately 164μs at maximum.

2. Write to flash-memory related registers by DMAC

   While an instruction in on-chip RAM is being executed, the DMAC can write to the SCO bit in FCCS that is used for a download request or FMATS that is used for MAT switching. Make sure that these registers are not accidentally written to, otherwise an on-chip program may be downloaded and damage RAM or a MAT switchover may occur and the CPU get out of control. Do not use DMAC to program FLASH related registers.

3. Compatibility with programming/erasing program of conventional F-ZTAT H8 microcomputer

   A programming/erasing program for flash memory used in the conventional F-ZTAT H8 microcomputer which does not support download of the on-chip program by a SCO transfer request cannot run in this LSI.

   Be sure to download the on-chip program to execute programming/erasing of flash memory in this LSI.

4. Monitoring runaway by WDT

   Unlike the conventional F-ZTAT H8 microcomputer, no countermeasures are available for a runaway by WDT during programming/erasing by the downloaded on-chip program.

   Prepare countermeasures (e.g. use of the user branch routine and periodic timer interrupts) for WDT while taking the programming/erasing time into consideration as required.

18.9 PROM Mode

Along with its on-board programming mode, this LSI also has a PROM mode as a further mode for the writing and erasing of programs and data. In the PROM mode, a general-purpose PROM programmer can freely be used to write programs to the on-chip ROM. Program/erase is possible on the user MAT and user boot MAT. The PROM programmer must support Renesas microcomputers with 512-kbyte flash memory units as a device type.

A status-polling system is adopted for operation in automatic program, automatic erase, and status-read modes. In the status-read mode, details of the system's internal signals are output after execution of automatic programming or automatic erasure. In the PROM mode, provide a 12-MHz input-clock signal.

Table 18.11 PROM Mode Pin

Pins	Setting
Mode pin: P82, P81, P80	1, 0, 0

18.9.1 Pin Arrangement of the Socket Adapter

Attach the socket adapter to the LSI in the way shown in figure 18.22. This allows conversion to 40 pins. Figure 18.21 shows the memory mapping of the on-chip ROM, and figure 18.22 shows the arrangement of the socket adapter's pins.

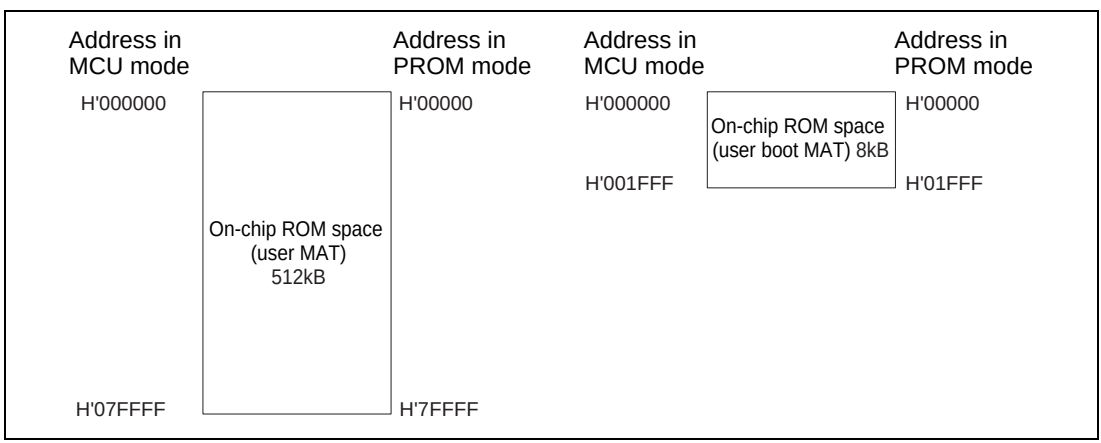


Figure 18.21 Mapping of On-Chip Flash Memory

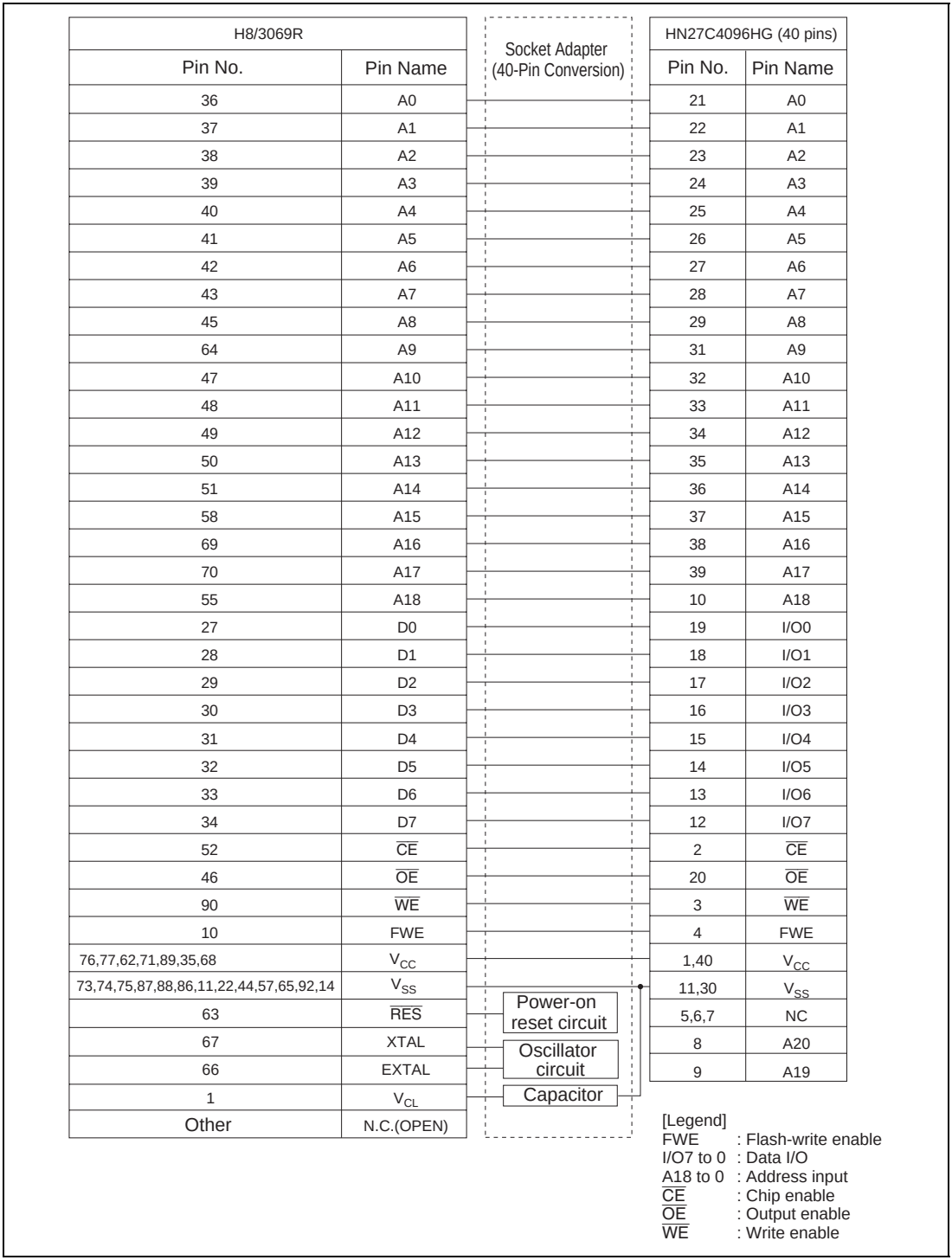


Figure 18.22 Pin Arrangement of the Socket Adapter

18.9.2 PROM Mode Operation

Table 18.12 shows the settings for the operating modes of PROM mode, and table 18.13 lists the commands used in PROM mode. The following sections provide detailed information on each mode.

- Memory-read mode: This mode supports reading, in units of bytes, from the user MAT or user boot MAT.
- Auto-program mode: This mode supports the simultaneous programming of the user MAT and user boot MAT in 128-byte units. Status polling is used to confirm the end of automatic programming.
- Auto-erase mode: This mode only supports the automatic erasing of the entire user MAT or user boot MAT. Status polling is used to confirm the end of automatic erasing.
- Status-read mode: Status polling is used with automatic programming and automatic erasure. Normal completion can be detected by reading the signal on the I/O6 pin. In status-read mode, error information is output when an error has occurred.

Table 18.12 Settings for Each Operating Mode of PROM Mode

	Pin Name					
Mode	**FWE**	**$\overline{CE}$**	**$\overline{OE}$**	**$\overline{WE}$**	**I/O7 to 0**	**A18 to 0**
Read	H or L	L	L	H	Data output	Ain
Output disable	H or L	L	H	H	Hi-Z	X
Command write	H or L	L	H	L	Data input	*Ain
Chip disable	H or L	H	X	X	Hi-Z	X

Notes: 1. The chip-disable mode is not a standby state; internally, it is an operational state.
2. To write commands when making a transition to the auto-program or auto-erase mode, input a high-level signal on the FWE pin.
* Ain indicates that there is also an address input in auto-program mode.

Table 18.13 Commands in PROM Mode

Command	Number of Cycles	Memory MAT to be Accessed	1st Cycle			2nd Cycle		
			Mode	Address	Data	Mode	Address	Data
Memory-read mode	1+n	User MAT	write	X	H'00	read	RA	Dout
		User boot MAT	write	X	H'05			
Auto-program mode	129	User MAT	write	X	H'40	write	WA	Din
		User boot MAT	write	X	H'45			
Auto-erase mode	2	User MAT	write	X	H'20	write	X	H'20
		User boot MAT	write	X	H'25			H'25
Status-read mode	2	Common to both MATs	write	X	H'71	write	X	H'71

Notes: 1. In auto-program mode, 129 cycles are required in command writing because of the simultaneous 128-byte write.
2. In memory read mode, the number of cycles varies with the number of address writing cycles (n).

18.9.3 Memory-Read Mode

(1) On completion of an automatic program, automatic erase, or status read, the LSI enters a command waiting state. So, to read the contents of memory after these operations, issue the command to change the mode to the memory-read mode before reading from the memory.

(2) In memory-read mode, the writing of commands is possible in the same way as in the command-write state.

(3) After entering memory-read mode, continuous reading is possible.

(4) After power has first been supplied, the LSI enters the memory-read mode. For the AC characteristics in memory read mode, see section 18.10.2, AC Characteristics and Timing in Writer Mode.

18.9.4 Auto-Program Mode

(1) In auto-program mode, programming is in 128-byte units. That is, 128 bytes of data are transferred in succession.

(2) Even in the programming of less than 128 bytes, 128 bytes of data must be transferred. H'FF should be written to those addresses that are unnecessarily written to.

(3) Set the low seven bits of the address to be transferred to low level. Inputting an invalid address will result in a programming error, although processing will proceed to the memory-programming operation.

(4) The memory address is transferred in the 2nd cycle. Do not transfer addresses in the 3rd or later cycles.

(5) Do not issue commands while programming is in progress.

(6) When programming, execute automatic programming once for each 128-byte block of addresses. Programming the block at an address where programming has already been performed is not possible.

(7) To confirm the end of automatic programming, check the signal on the I/O6 pin. Confirmation in the status-read mode is also possible (status polling of the I/O7 pin is used to check the end status of automatic programming).

(8) Status-polling information on the I/O6 and I/O7 pins is retained until the next command is written. As long as no command is written, the information is made readable by setting $\overline{CE}$ and $\overline{OE}$ for enabling.

For the AC characteristics in auto-program mode, see section 18.10.2, AC Characteristics and Timing in Writer Mode.

18.9.5 Auto-Erase Mode

(1) Auto-erase mode only supports erasing of the entire memory.

(2) Do not perform command writing during auto erasing is in progress.

(3) To confirm the end of automatic erasing, check the signal on the I/O6 pin. Confirmation in the status-read mode is also possible (status polling of the I/O7 pin is used to check the end status of automatic erasure).

(4) Status polling information on the I/O6 and I/O7 pins is retained until the next command writing. As long as no command is written, the information is made readable by setting $\overline{CE}$ and $\overline{OE}$ for enabling.

For the AC characteristics in auto-erase mode, see section 18.10.2, AC Characteristics and Timing in Writer Mode.

18.9.6 Status-Read Mode

(1) Status-read mode is used to determine the type of an abnormal termination. Use this mode when automatic programming or automatic erasure ends abnormally.

(2) The return code is retained until writing of a command that selects a mode other than status-read mode.

Table 18.14 lists the return codes of status-read mode.

For the AC characteristics in status-read mode, see section 18.10.2, AC Characteristics and Timing in Writer Mode.

Table 18.14 Return Codes of Status-Read Mode

Pin Name	I/O7	I/O6	I/O5	I/O4	I/O3	I/O2	I/O1	I/O0
Attribute	Normal end indicator	Command error	Program-ming error	Erase error	—	—	Programming or erase count exceeded	Invalid address error
Initial value	0	0	0	0	0	0	0	0
Indication	Normal end: 0 Abnormal end: 1	Command error: 1 Otherwise: 0	Program-ming error: 1 Otherwise: 0	Erase error:1 Otherwise: 0	—	—	Count exceeded: 1 Otherwise: 0	Invalid address error: 1 Otherwise: 0

Note: I/O2 and I/O3 are undefined pins.

18.9.7 Status Polling

(1) The I/O7 status-polling output is a flag that indicates the operating status in auto-program or auto-erase mode.

(2) The I/O6 status-polling output is a flag that indicates normal/abnormal end of auto-program or auto-erase mode.

Table 18.15 Truth Table of Status-Polling Output

Pin Name	In Progress	Abnormal End	—	Normal End
I/O7	0	1	0	1
I/O6	0	0	1	1
I/O0 to 5	0	0	0	0

18.9.8 Time Taken in Transition to PROM Mode

Until oscillation has stabilized and while PROM mode is being set up, the LSI is unable to accept commands. After the PROM-mode setup time has elapsed, the LSI enters memory-read mode. See section 18.10.2, AC Characteristics and Timing in Writer Mode.

18.9.9 Notes on Using PROM Mode

(1) When programming addresses which have previously been programmed, apply auto-erasing before auto-programming (figure 18.24).

(2) When using PROM mode to program a chip that has been programmed/erased in an on-board programming mode, auto-erasing before auto-programming is recommended.

(3) Do not take the chip out of the PROM programmer or reset the chip during programming or erasure. Flash memory is susceptible to permanent damage since a high voltage is being applied during the programming/erasing. When the reset signal is accidentally input to the chip, the period in the reset state until the reset signal is released should be longer than the normal 100 μs.

(4) The flash memory is initially in the erased state when the device is shipped by Renesas Technology. For other chips for which the history of erasure is unknown, auto-erasing as a check and supplement for the initialization (erase) level is recommended.

(5) This LSI does not support modes such as the product identification mode of general purpose EPROM. Therefore, the device name is not automatically set in the PROM programmer.

(6) For further information on the PROM programmer and its software version, please refer to the instruction manual for the socket adapter.

18.10 Further Information

18.10.1 Serial Communication Interface Specification for Boot Mode

Initiating boot mode enables the boot program to communicate with the host by using the internal SCI. The serial communication interface specification is shown below.

- Status

The boot program has three states.

(1) Bit-Rate-Adjustment State

In this state, the boot program adjusts the bit rate to communicate with the host. Initiating boot mode enables starting of the boot program and entry to the bit-rate-adjustment state. The program receives the command from the host to adjust the bit rate. After adjusting the bit rate, the program enters the inquiry/selection state.

(2) Inquiry/Selection State

In this state, the boot program responds to inquiry commands from the host. The device name, clock mode, and bit rate are selected. After selection of these settings, the program is made to enter the programming/erasing state by the command for a transition to the programming/erasing state. The program transfers the libraries required for erasure to the RAM and erases the user MATs and user boot MATs before the transition.

(3) Programming/erasing state

Programming and erasure by the boot program take place in this state. The boot program is made to transfer the programming/erasing programs to the RAM by commands from the host. Sum checks and blank checks are executed by sending these commands from the host.

These boot program states are shown in figure 18.23.

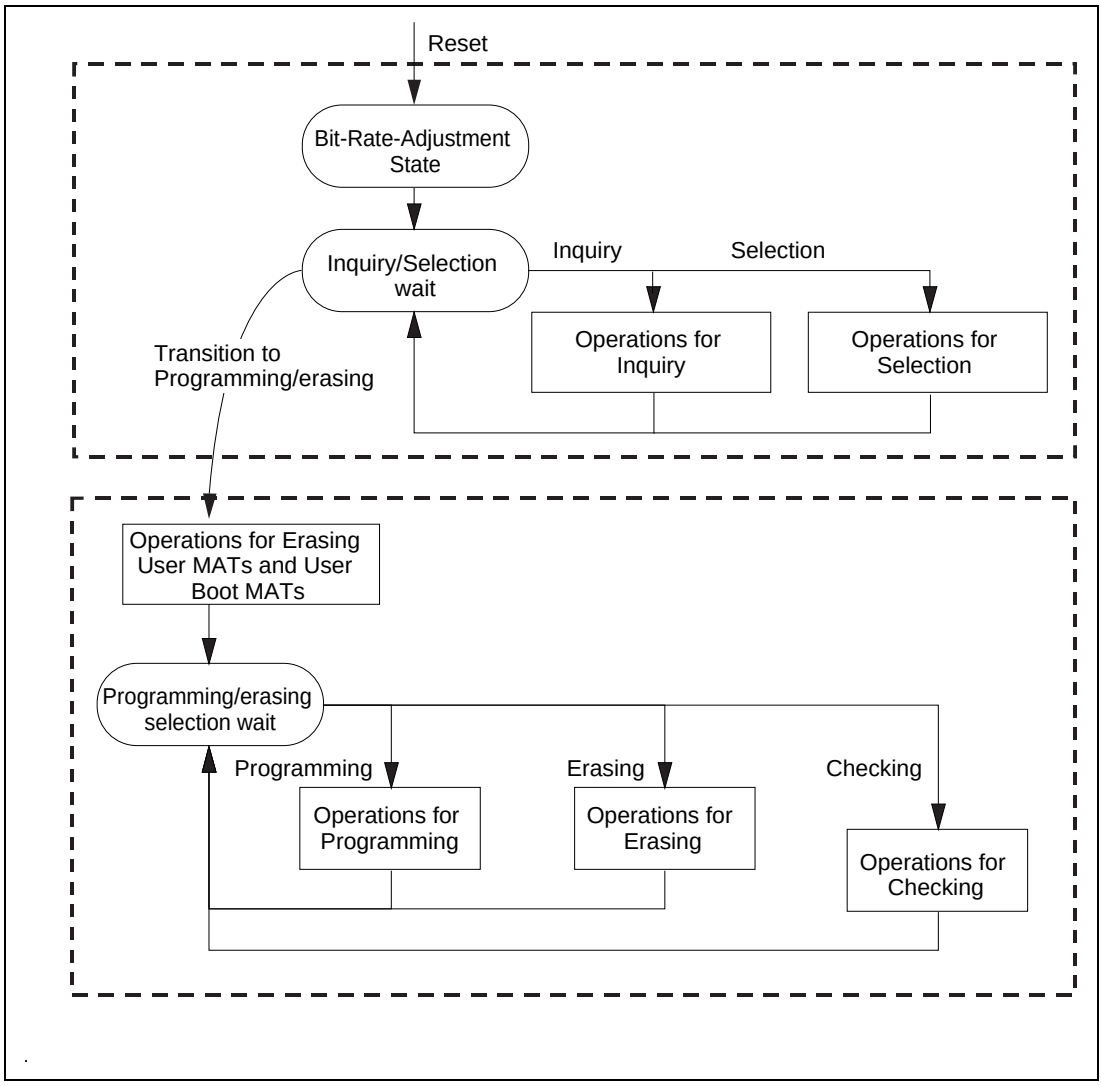


Figure 18.23 Boot Program States

- Bit-Rate-Adjustment state

The bit rate is calculated by measuring the period of transfer of a low-level byte (H'00) from the host. The bit rate can be changed by the command for a new bit rate selection. After the bit rate has been adjusted, the boot program enters the inquiry and selection state. The bit-rate-adjustment sequence is shown in figure 18.24.

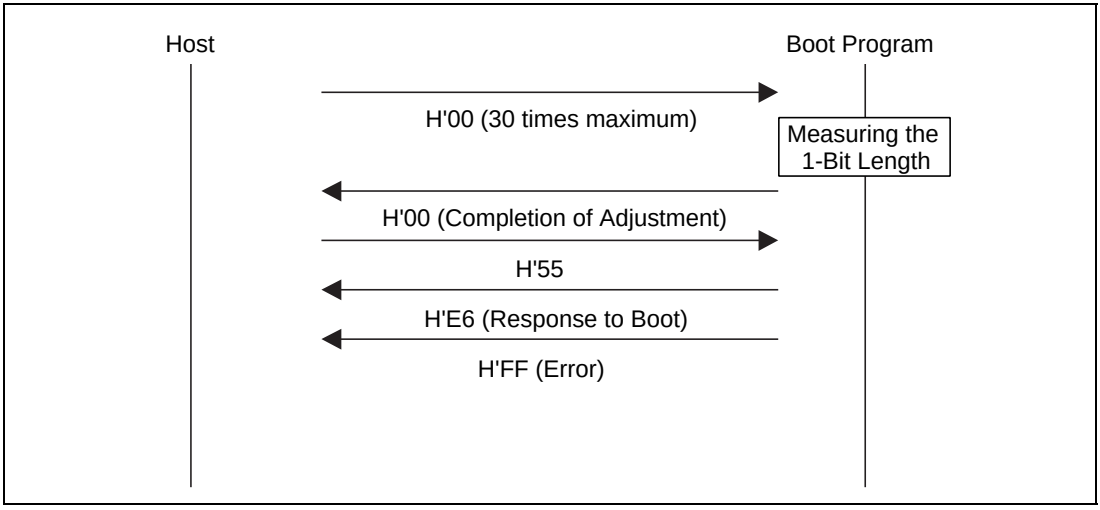


Figure 18.24 Bit-Rate-Adjustment Sequence

- Communications Protocol

After adjustment of the bit rate, the protocol for communications between the host and the boot program is as shown below.

(1) One-byte commands and one-byte responses

These commands and responses are comprised of a single byte. These are consists of the inquiries and the ACK for successful completion.

(2) n-byte commands or n-byte responses

These commands and responses are comprised of n bytes of data. These are selections and responses to inquiries.

The amount of programming data is not included under this heading because it is determined in another command.

(3) Error response

The error response is a response to inquiries. It consists of an error response and an error code and comes two bytes.

(4) Programming of 128 bytes

The size is not specified in commands. The size of n is indicated in response to the programming unit inquiry.

(5) Memory read response

This response consists of four bytes of data.

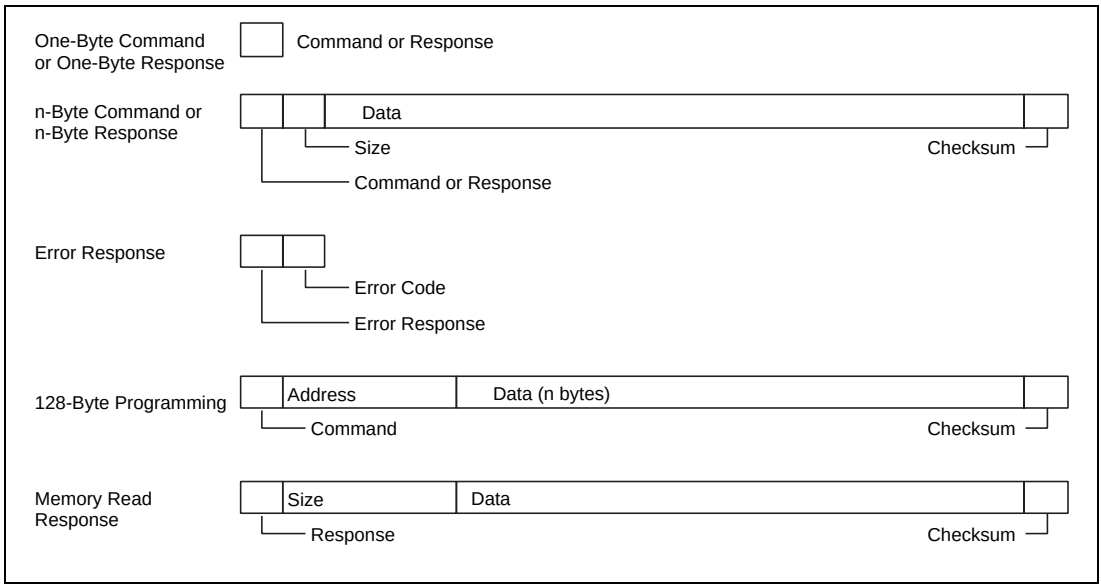


Figure 18.25 Communication Protocol Format

- Command (1 byte) : Commands including inquiries, selection, programming, erasing, and checking
- Response (1 byte) : Response to an inquiry
- Size (1 byte) : The amount of data for transmission excluding the command, amount of data, and checksum
- Checksum (1 byte) : The checksum is calculated so that the total of all values from the command byte to the SUM byte becomes H'00.
- Data (n bytes) : Detailed data of a command or response
- Error Response (1 byte) : Error response to a command
- Error Code (1 byte) : Type of the error
- Address (4 bytes) : Address for programming
- Data (n bytes) : Data to be programmed (the size is indicated in the response to the programming unit inquiry.)
- Size (4 bytes) : Four-byte response to a memory read

- Inquiry and Selection States

The boot program returns information from the flash memory in response to the host's inquiry commands and sets the device code, clock mode, and bit rate in response to the host's selection command.

Inquiry and selection commands are listed below.

Table 18.16 Inquiry and Selection Commands

Command	Command Name	Description
H'20	Supported Device Inquiry	Inquiry regarding device codes and product names of F-ZTAT
H'10	Device Selection	Selection of device code
H'21	Clock Mode Inquiry	Inquiry regarding numbers of clock modes and values of each mode
H'11	Clock Mode Selection	Indication of the selected clock mode
H'22	Multiplication Ratio Inquiry	Inquiry regarding the number of frequency-multiplied clock types, the number of multiplication ratios, and the values of each multiple
H'23	Operating Clock Frequency Inquiry	Inquiry regarding the maximum and minimum values of the main clock and peripheral clocks
H'24	User Boot MAT Information Inquiry	Inquiry regarding the number of user boot MATs and the start and last addresses of each MAT
H'25	User MAT Information Inquiry	Inquiry regarding the a number of user MATs and the start and last addresses of each MAT
H'26	Block for Erasing Information Inquiry	Inquiry regarding the number of blocks and the start and last addresses of each block
H'27	Programming Unit Inquiry	Inquiry regarding the unit of programming data
H'3F	New Bit Rate Selection	Selection of new bit rate
H'40	Transition to Programming/erasing State	Erasing of user MAT and user boot MAT, and entry to programming/erasing state
H'4F	Boot Program Status Inquiry	Inquiry into the operated status of the boot program

The selection commands, which are device selection (H'10), clock mode selection (H'11), and new bit rate selection (H'3F), should be sent from the host in that order. These commands will

certainly be needed. When two or more selection commands are sent at once, the last command will be valid.

All of these commands, except for the boot program status inquiry command (H'4F), will be valid until the boot program receives the programming/erasing transition (H'40). The host can choose the needed commands out of the commands and inquiries listed above. The boot program status inquiry command (H'4F) is valid after the boot program has received the programming/erasing transition command (H'40).

(1) Supported device inquiry

The boot program will return the device codes of supported devices and the product code of the F-ZTAT in response to the supported device inquiry.

Command

H'20

— Command, H'20, (1 byte) : Inquiry regarding supported devices

Response

H'30	Size	A number of devices	
A number of characters	Device code		Product name
…			
SUM			

— Response, H'30, (1 byte) : Response to the supported device inquiry

— Size (1 byte) : Number of bytes to be transmitted, excluding the command, amount of data, and checksum, that is, the amount of data contributes by the product names, the number of devices, characters, and device codes

— A number of devices (1 byte) : The number of device types supported by the boot program

— A number of characters (1 byte) : The number of characters in the device codes and boot program's name

— Device code (4 bytes) : Code of the supporting product

— Product name (n bytes) : Type name of the boot program in ASCII-coded characters

— SUM (1 byte) : Checksum
The checksum is calculated so that the total number of all values from the command byte to the SUM byte becomes H'00.

(2) Device Selection

The boot program will set the supported device to the specified device code. The program will return the selected device code in response to the inquiry after this setting has been made.

Command

H'10	Size	Device code	SUM

— Command, H'10, (1 byte) : Device selection

— Size (1 byte) : Amount of device-code data
This is fixed to 4
— Device code (4 bytes) : Device code returned in response to the supported device inquiry (ASCII-code)
— SUM (1 byte) : Checksum

Response	H'06

— Response, H'06, (1 byte) : Response to the device selection command
ACK will be returned when the device code matches.

Error response	H'90	ERROR

— Error response, H'90, (1 byte) : Error response to the device selection command
— Error : (1 byte) : Error code
H'11 : Sum check error
H'21 : Device code error, that is, the device code does not match

(3) Clock Mode Inquiry

The boot program will return the supported clock modes in response to the clock mode inquiry.

Command	H'21

— Command, H'21, (1 byte) : Inquiry regarding clock mode

Response	H'31	Size	A number of modes	Mode	SUM

— Response, H'31, (1 byte) : Response to the clock-mode inquiry
— Size (1 byte) : Amount of data that represents the number of modes and modes
— A number of clock modes (1 byte) : The number of supported clock modes
H'00 indicates no clock mode or the device allows to read the clock mode.
— Mode (1 byte) : Values of the supported clock modes (i.e. H'01 means clock mode 1.)
— SUM (1 byte) : Checksum

(4) Clock Mode Selection

The boot program will set the specified clock mode. The program will return the selected clock-mode information after this setting has been made.

The clock-mode selection command should be sent after the device-selection commands.

Command	H'11	Size	Mode	SUM

— Command, H'11, (1 byte) : Selection of clock mode
— Size (1 byte) : Amount of data that represents the modes

— Mode (1 byte) : A clock mode returned in reply to the supported clock mode inquiry.
— SUM (1 byte) : Checksum

Response

H'06

— Response, H'06, (1 byte) : Response to the clock mode selection command
ACK will be returned when the clock mode matches.

Error response

H'91	ERROR

— Error response, H'91, (1 byte) : Error response to the clock mode selection command
— ERROR, (1 byte) : Error code
H'11 : Checksum error
H'22 : Clock mode error, that is, the clock mode does not match.

Even when the clock mode value is H'00 or H'01 for clock mode inquiry, clock mode selection is performed for each value.

(5) Multiplication Ratio-Inquiry

The boot program will return the supported multiplication and division ratios.

Command

H'22

— Command, H'22, (1 byte) : Inquiry regarding multiplication ratio

Response

H'32	Size	The Number of Clock					
The number of multiplication ratios	Multiplication ratio	…					
…							
SUM							

— Response, H'32, (1 byte) : Response to the multiplication ratio inquiry
— Size (1 byte) : The amount of data that represents the clock sources, the number of multiplication ratios, and the multiplication ratios
— A number of types (1 byte) : The number of supported multiplied clock types
(e.g. when there are two multiplied clock types, which are the main and peripheral clocks, the number of types will be H'02.)

— A number of multiplication ratios (1 byte) : The number of multiplication ratios for each type

(e.g. the number of multiplication ratios to which the main clock can be set and the peripheral clock can be set.)

— Multiplication ratio (1 byte)

— Multiplication ratio : The value of the multiplication ratio (e.g. when the clock-frequency multiplier is four, the value of multiplication ratio will be H'04.)

— Division ratio : The inverse of the division ratio, i.e. a negative number (e.g. when the clock is divided by two, the value of division ratio will be H'FE. H'FE = D'-2) The number of multiplication ratios returned is the same as the number of multiplication ratios and as many groups of data are returned as there are types.

— SUM (1 byte) : Checksum

(6) Operating Clock Frequency Inquiry

The boot program will return the number of operating clock frequencies, and the maximum and minimum values.

Command

H'23

— Command, H'23, (1 byte) : Inquiry regarding operating clock frequencies

Response

H'33	Size	A number of operating clock frequencies
The minimum value of operating clock frequency		The maximum value of operating clock frequency
…		
SUM		

— Response, H'33, (1 byte) : Response to operating clock frequency inquiry

— Size (1 byte) : The number of bytes that represents the minimum values, maximum values, and the number of types.

— A number of types (1 byte) : The number of supported operating clock frequency types

(e.g. when there are two operating clock frequency types, which are the main and peripheral clocks, the number of types will be H'02.)

— Minimum value of operating clock frequency (2 bytes) : The minimum value of the multiplied or divided clock frequency.

The minimum and maximum values represent the values in MHz, valid to the hundredths place of MHz, and multiplied by 100. (e.g. when the value is 20.00 MHz, it will be D'2000 and H'07D0.)

— Maximum value (2 bytes) : Maximum value among the multiplied or divided clock frequencies.

There are as many pairs of minimum and maximum values as there are operating clock frequencies.

— SUM (1 byte) : Checksum

(7) User Boot MAT Information Inquiry

The boot program will return the number of user boot MATs and their addresses.

Command

H'24

— Command, H'24, (1 byte) : Inquiry regarding user boot MAT information

Response

H'34	Size	A Number of Areas	
Area-Start Address			Area-Last Address
…			
SUM			

— Response, H'34, (1 byte) : Response to user boot MAT information inquiry

— Size (1 byte) : The number of bytes that represents the number of areas, area-start addresses, and area-last address

— A Number of Areas (1 byte) : The number of non-consecutive user boot MAT areas
When user boot MAT areas are consecutive, the number of areas returned is H'01.

— Area-Start Address (4 bytes) : Start address of the area

— Area-Last Address (4 bytes) : Last address of the area

There are as many groups of data representing the start and last addresses as there are areas.

— SUM (1 byte) : Checksum

(8) User MAT Information Inquiry

The boot program will return the number of user MATs and their addresses.

Command

H'25

— Command, H'25, (1 byte) : Inquiry regarding user MAT information

Response

H'35	Size	A Number of Areas

Area-Start Address	Area-Last Address
…	

SUM

— Response, H'35, (1 byte) : Response to the user MAT information inquiry

— Size (1 byte) : The number of bytes that represents the number of areas, area-start address and area-last address

— A Number of Areas (1 byte) : The number of non-consecutive user MAT areas

When the user MAT areas are consecutive, the number of areas is H'01.

— Area-Start Address (4 bytes) : Start address of the area

— Area-Last Address (4 bytes) : Last address of the area

There are as many groups of data representing the start and last addresses as there are areas.

— SUM (1 byte) : Checksum

(9) Erased Block Information Inquiry

The boot program will return the number of erased blocks and their addresses.

Command

H'26

— Command, H'26, (1 byte) : Inquiry regarding erased block information

Response

H'36	Size	A number of blocks

Block Start Address	Block Last Address
…	

SUM

— Response, H'36, (1 byte) : Response to the number of erased blocks and addresses

— Size (1 byte) : The number of bytes that represents the number of blocks, block-start addresses, and block-last addresses.

— A number of blocks (1 byte) : Number of erased blocks in flash memory

— Block Start Address (4 bytes) : Start address of a block

— Block Last Address (4 bytes) : Last address of a block

There are as many groups of data representing the start and last addresses as there are blocks.

— SUM : Checksum

(10) Programming Unit Inquiry

The boot program will return the programming unit used to program data.

Command	H'27

— Command, H'27, (1 byte) : Inquiry regarding programming unit

Response	H'37	Size	Programming unit	SUM

— Response, H'37, (1 byte) : Response to programming unit inquiry

— Size (1 byte) : The number of bytes that indicate the programming unit, which is fixed to 2

— Programming unit (2 bytes) : A unit for programming

This is the unit for reception of programming.

— SUM (1 byte) : Checksum

(11) New Bit-Rate Selection

The boot program will set a new bit rate and return the new bit rate.

This selection should be sent after sending the clock mode selection command.

Command	H'3F	Size	Bit rate	Input frequency
	Number of multiplication ratios	Multiplication ratio 1	Multiplication ratio 2	
	SUM			

— Command, H'3F, (1 byte) : Selection of new bit rate

— Size (1 byte) : The number of bytes that represents the bit rate, input frequency, number of multiplication ratios, and multiplication ratio

— Bit rate (2 bytes) : New bit rate
One hundredth of the value (e.g. when the value is 19200 bps, the bit rate is H'00C0, which is D'192.)

— Input frequency (2 bytes) : Frequency of the clock input to the boot program
This is valid to the hundredths place and represents the value in MHz multiplied by 100. (e.g. when the value is 20.00 MHz, the input frequency is H'07D0 (= D'2000).)

— Number of multiplication ratios (1 byte) : The number of multiplication ratios to which the device can be set. Normally the value is two: main operating frequency and peripheral module operating frequency. (With this LSI it should be set to H'01.)

— Multiplication ratio 1 (1 byte) : The value of multiplication or division ratios for the main operating frequency

— Multiplication ratio (1 byte) : The value of the multiplication ratio (e.g. when the clock frequency is multiplied by four, the multiplication ratio will be H'04. With this LSI it should be set to H'01.)

— Division ratio : The inverse of the division ratio, as a negative number (e.g. when the clock frequency is divided by two, the value of division ratio will be H'FE. H'FE = D'-2. With this LSI it should be set to H'01.)

— Multiplication ratio 2 (1 byte) : The value of multiplication or division ratios for the peripheral frequency

— Multiplication ratio (1 byte) : The value of the multiplication ratio (e.g. when the clock frequency is multiplied by four, the multiplication ratio will be H'04. Cannot be set for this LSI.)

— Division ratio : The inverse of the division ratio, as a negative number (e.g. when the clock is divided by two, the value of division ratio will be H'FE. H'FE = D'-2. With this LSI it should be set to H'01.)

— SUM (1 byte) : Checksum

Response

H'06

— Response, H'06, (1 byte) : Response to selection of a new bit rate

When it is possible to set the bit rate, the response will be ACK.

Error response

H'BF	ERROR

— Error response, H'BF, (1 byte) : Error response to selection of new bit rate

— ERROR : (1 byte) : Error code

H'11 : Sum checking error

H'24 : Bit-rate selection error

The rate is not available.

H'25 : Error in input frequency

This input frequency is not within the specified range.

H'26 : Multiplication-ratio error*

The ratio does not match an available ratio.

H'27 : Operating frequency error*

The frequency is not within the specified range.

Note: * This error does not occur with this LSI.

- Received data check

The methods for checking of received data are listed below.

(1) Input frequency

The received value of the input frequency is checked to ensure that it is within the range of minimum to maximum frequencies which matches the clock modes of the specified device. When the value is out of this range, an input-frequency error is generated.

(2) Multiplication ratio

The received value of the multiplication ratio or division ratio is checked to ensure that it matches the clock modes of the specified device. When the value is out of this range, an input-frequency error is generated.

(3) Operating frequency error

Operating frequency is calculated from the received value of the input frequency and the multiplication or division ratio. The input frequency is input to the LSI and the LSI is operated at the operating frequency. The expression is given below.

Operating frequency = Input frequency • Multiplication ratio , or

Operating frequency = Input frequency ÷ Division ratio

The calculated operating frequency should be checked to ensure that it is within the range of minimum to maximum frequencies which are available with the clock modes of the specified device. When it is out of this range, an operating frequency error is generated.

(4) Bit rate

Peripheral operating clock (ϕ), bit rate (B), clock select (CKS) in the serial mode register (SMR).

The error as calculated by the method below is checked to ensure that it is less than 4%. When it is 4% or more, a bit-rate selection error is generated.

$$\text{Error (\%)} = \{[\frac{\phi \bullet 10^6}{(N+1) \bullet B \bullet 64 \bullet 2^{(2 \bullet n-1)}}] - 1\} \bullet 100$$

When the new bit rate is selectable, the rate will be set in the register after sending ACK in response. The host will send an ACK with the new bit rate for confirmation and the boot program will response with that rate.

Confirmation | H'06

— Confirmation, H'06, (1 byte) : Confirmation of a new bit rate

Response | H'06

— Response, H'06, (1 byte) : Response to confirmation of a new bit rate

The sequence of new bit-rate selection is shown in figure 18.26.

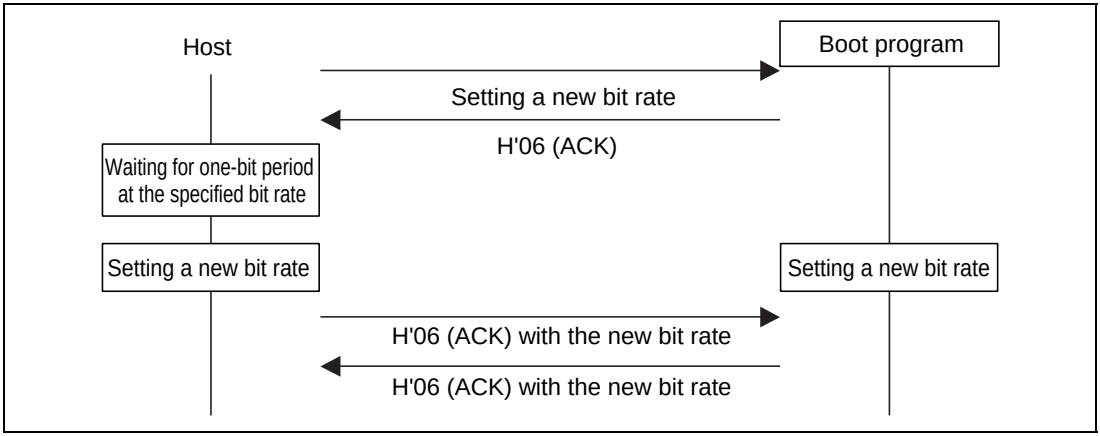


Figure 18.26 New Bit-Rate Selection Sequence

- Transition to Programming/Erasing State

The boot program will transfer the erasing program, and erase the user MATs and user boot MATs in that order. On completion of this erasure, ACK will be returned and will enter the programming/erasing state.

The host should select the device code, clock mode, and new bit rate with device selection, clock-mode selection, and new bit-rate selection commands, and then send the command for the transition to programming/erasing state. These procedure should be carried out before sending of the programming selection command or program data.

Command	H'40

— Command, H'40, (1 byte) : Transition to programming/erasing state

Response	H'06

— Response, H'06, (1 byte) : Response to transition to programming/erasing state

The boot program will send ACK when the user MAT and user boot MAT have been erased by the transferred erasing program.

Error response	H'C0	H'51

— Error response, H'C0, (1 byte) : Error response for user boot MAT blank check

— Error code, H'51, (1 byte) : Erasing error

An error occurred and erasure was not completed.

- Command Error

A command error will occur when a command is undefined, the order of commands is incorrect, or a command is unacceptable. Issuing a clock-mode selection command before a device selection or an inquiry command after the transition to programming/erasing state command, are examples.

Error response	H'80	H'xx

— Error response, H'80, (1 byte) : Command error

— Command, H'xx, (1 byte) : Received command

- Command Order

The order for commands in the inquiry selection state is shown below.

(1) A supported device inquiry (H'20) should be made to inquire about the supported devices.

(2) The device should be selected from among those described by the returned information and set with a device-selection (H'10) command.

(3) A clock-mode inquiry (H'21) should be made to inquire about the supported clock modes.

(4) The clock mode should be selected from among those described by the returned information and set.

(5) After selection of the device and clock mode, inquiries for other required information should be made, such as the multiplication-ratio inquiry (H'22) or operating frequency inquiry (H'23).

(6) A new bit rate should be selected with the new bit-rate selection (H'3F) command, according to the returned information on multiplication ratios and operating frequencies.

(7) After selection of the device and clock mode, the information of the user boot MAT and user MAT should be made to inquire about the user boot MATs information inquiry (H'24), user MATs information inquiry (H'25), erased block information inquiry (H'26), programming unit inquiry (H'27).

(8) After making inquiries and selecting a new bit rate, issue the transition to programming/erasing state (H'40) command. The boot program will then enter the programming/erasing state.

- Programming/erasing State

A programming selection command makes the boot program select the programming method, an 128-byte programming command makes it program the memory with data, and an erasing selection command and block erasing command make it erase the block. The programming/erasing commands are listed below.

Table 18.17 Programming/erasing Command

Command	Command Name	Description
H'42	User boot MAT programming selection	Transfers the user boot MAT programming program
H'43	User MAT programming selection	Transfers the user MAT programming program
H'50	128-byte programming	Programs 128 bytes of data
H'48	Erasing selection	Transfers the erasing program
H'58	Block erasing	Erases a block of data
H'52	Memory read	Reads the contents of memory
H'4A	User boot MAT sum check	Checks the checksum of the user boot MAT
H'4B	User MAT sum check	Checks the checksum of the user MAT
H'4C	User boot MAT blank check	Checks whether the contents of the user boot MAT are blank
H'4D	User MAT blank check	Checks whether the contents of the user MAT are blank
H'4F	Boot program status inquiry	Inquires into the boot program's status

- Programming

Programming is executed by a programming-selection command and an 128-byte programming command.

Firstly, the host should send the programming-selection command and select the programming method and programming MATs. There are two programming selection commands, and selection is according to the area and method for programming.

(1) User boot MAT programming selection

(2) User MAT programming selection

After issuing the programming selection command, the host should send the 128-byte programming command. The 128-byte programming command that follows the selection command represents the data programmed according to the method specified by the selection command. When more than 128-byte data is programmed, 128-byte commands should repeatedly be executed. Sending an 128-byte programming command with H'FFFFFFFF as the address will stop the programming. On completion of programming, the boot program will wait for selection of programming or erasing.

Where the sequence of programming operations that is executed includes programming with another method or of another MAT, the procedure must be repeated from the programming selection command.

The sequence for programming-selection and 128-byte programming commands is shown in figure 18.27.

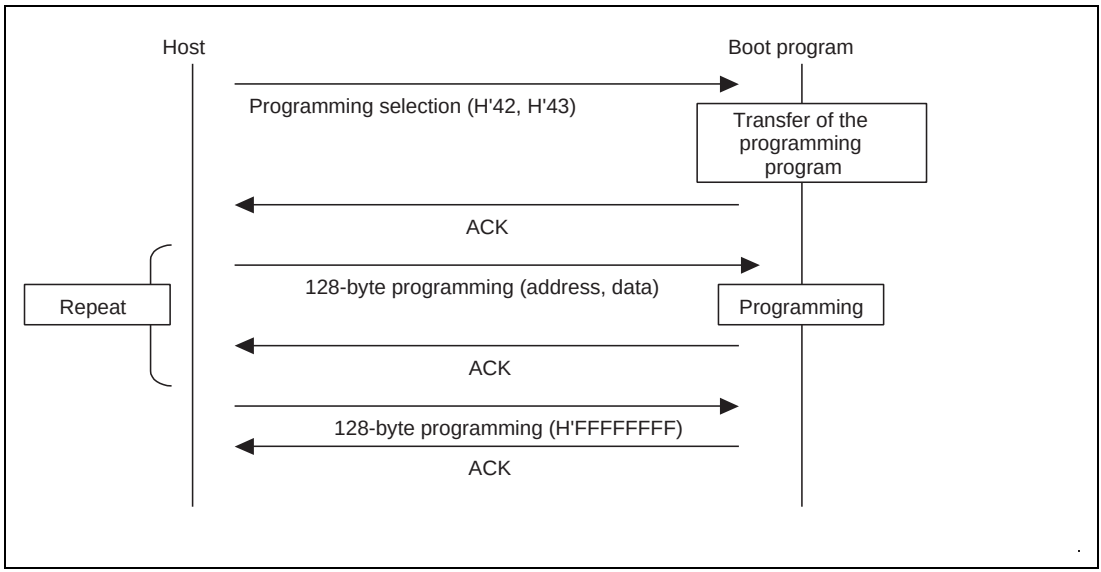


Figure 18.27 Programming Sequence

(1) User boot MAT programming selection

The boot program will transfer a programming program. The data is programmed to the user boot MATs by the transferred programming program.

Command	H'42

— Command, H'42, (1 byte) : User boot-program programming selection

Response	H'06

— Response, H'06, (1 byte) : Response to user boot-program programming selection

When the programming program has been transferred, the boot program will return ACK.

Error response	H'C2	ERROR

— Error response : H'C2 (1 byte): Error response to user boot MAT programming selection

— ERROR : (1 byte): Error code

H'54 : Selection processing error (transfer error occurs and processing is not completed)

(2) User MAT programming selection.

The boot program will transfer a programming program. The data is programmed to the user MATs by the transferred programming program.

Command	H'43

— Command, H'43, (1 byte) : User-program programming selection

Response	H'06

— Response, H'06, (1 byte) : Response to user-program programming selection

When the programming program has been transferred, the boot program will return ACK.

Error response	H'C3	ERROR

— Error response: H'C3 (1 byte): Error response to user MAT programming selection

— ERROR: (1 byte): Error code

H'54: Selection processing error (transfer error occurs and processing is not completed)

(3) 128-byte programming

The boot program will use the programming program transferred by the programming selection to program the user boot MATs or user MATs.

Command	H'50	Address						
	Data	…						
	…							
	SUM							

— Command, H'50, (1 byte) : 128-byte programming

— Programming Address (4 bytes) : Start address for programming

Multiple of the size specified in response to the programming unit inquiry
(i.e. H'00, H'01, H'00, H'00 : H'00010000)

— Programming Data (128 bytes) : Data to be programmed

The size is specified in the response to the programming unit inquiry.

— SUM (1 byte) : Checksum

Response	H'06

— Response, H'06, (1 byte) : Response to 128-byte programming

On completion of programming, the boot program will return ACK.

Error response	H'D0	ERROR

— Error response, H'D0, (1 byte) : Error response for 128-byte programming

— ERROR : (1 byte) : Error code

H'11 : Checksum Error

H'28 : Address error

The address is not within the specified range.

H'53 : Programming error

A programming error has occurred and programming cannot be continued.

The specified address should match the unit for programming of data. For example, when the programming is in 128-byte units, the lower byte of the address should be H'00 or H'80. When there are less than 128 bytes of data to be programmed, the host should fill the rest with H'FF.

Sending the 128-byte programming command with the address of H'FFFFFFFF will stop the programming operation. The boot program will interpret this as the end of the programming and wait for selection of programming or erasing.

Command	H'50	Address	SUM

— Command, H'50, (1 byte) : 128-byte programming

— Programming Address (4 bytes) : End code is H'FF, H'FF, H'FF, H'FF.

— SUM (1 byte) : Checksum

Response	H'06

— Response: H'06 (1 byte): Response to 128-byte programming

On completion of programming, the boot program will return ACK.

Error response	H'D0	ERROR

— Error Response, H'D0, (1 byte) : Error response for 128-byte programming

— ERROR : (1 byte) : Error code

H'11 : Checksum error

H'53 : Programming error

An error has occurred in programming and programming cannot be continued.

- Erasure

Erasure is performed with the erasure selection and block erasure command.

Firstly, erasure is selected by the erasure selection command and the boot program then erases the specified block. The command should be repeatedly executed if two or more blocks are to be erased. Sending a block-erasure command from the host with the block number H'FF will stop the erasure operating. On completion of erasing, the boot program will wait for selection of programming or erasing.

The sequences of the issuing of erasure selection commands and the erasure of data are shown in figure 18.28.

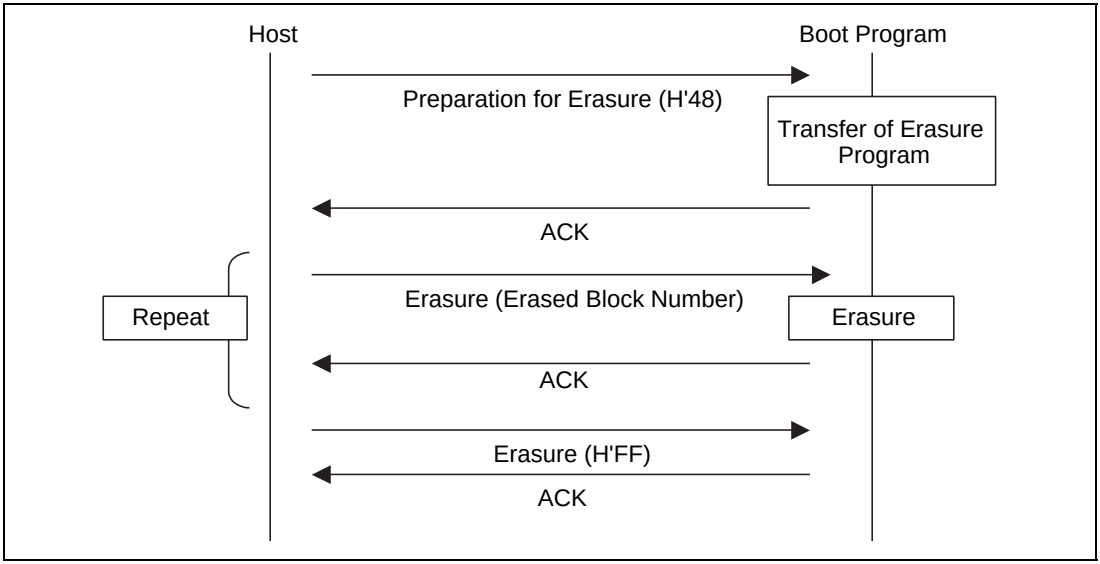


Figure 18.28 Erasure Sequence

(1) Erasure Selection

The boot program will transfer the erasure program. User MAT data is erased by the transferred erasure program.

Command	H'48

— Command, H'48, (1 byte) : Erasure selection

Response	H'06

— Response, H'06, (1 byte) : Response for erasure selection

After the erasure program has been transferred, the boot program will return ACK.

Error response	H'C8	ERROR

— Error response: H'C8 (1 byte): Error response to erasing selection

— ERROR: (1 byte): Error code

H'54: Selection processing error (transfer error occurs and processing is not completed)

(2) Block Erasure

The boot program will erase the contents of the specified block.

Command	H'58	Size	Block Number	SUM

— Command, H'58, (1 byte) : Erasure

— Size (1 byte) : The number of bytes that represents the erasure block number

This is fixed to 1.

— Block Number (1 byte) : Number of the block to be erased

— SUM (1 byte) : Checksum

Response	H'06

— Response, H'06, (1 byte) : Response to Erasure

After erasure has been completed, the boot program will return ACK.

Error response	H'D8	ERROR

— Error Response, H'D8, (1 byte) : Error code

— ERROR (1 byte) : Error code

H'11 : Sum check error

H'29 : Block number error

Block number is incorrect.

H'51 : Erasure error

An error has occurred during erasure.

On receiving block number H'FF, the boot program will stop erasure and wait for a selection command.

Command	H'58	Size	Block Number	SUM

— Command, H'58, (1 byte) : Erasure

— Size (1 byte) : The number of bytes that represents the block number

This is fixed to 1.

— Block Number (1 byte) : H'FF

Stop code for erasure

— SUM (1 byte) : Checksum

Response	H'06

— Response, H'06, (1 byte) : Response to end of erasure (ACK)

When erasure is to be performed after the block number H'FF has been sent, the procedure should be executed from the erasure selection command.

- Memory read

The boot program will return the data in the specified address.

Command	H'52	Size	Area	Read address	
	Read size				SUM

— Command: H'52 (1 byte): Memory read

— Size (1 byte): Amount of data that represents the area, read address, and read size (fixed at 9)

— Area (1 byte)

H'00 : User boot MAT

H'01 : User MAT

An address error occurs when the area setting is incorrect.

— Read address (4 bytes): Start address to be read from

— Read size (4 bytes): Size of data to be read

— SUM (1 byte): Checksum

Response

H'52	Read size							
Data	…							
SUM								

— Response: H'52 (1 byte): Response to memory read

— Read size (4 bytes): Size of data to be read

— Data (n bytes): Data for the read size from the read address

— SUM (1 byte): Checksum

Error response

H'D2	ERROR

— Error response: H'D2 (1 byte): Error response to memory read

— ERROR: (1 byte): Error code

H'11: Sum check error

H'2A: Address error

The read address is not in the MAT.

H'2B: Size error

The read size exceeds the MAT.

- User-Boot Program Sum check

The boot program will return the byte-by-byte total of the contents of the bytes of the user-boot program.

Command

H'4A

— Command, H'4A, (1 byte) : Sum check for user-boot program

Response

H'5A	Size	Checksum of user boot program	SUM

— Response, H'5A, (1 byte) : Response to the sum check of user-boot program

— Size (1 byte) : The number of bytes that represents the checksum

This is fixed to 4.

— Checksum of user boot program (4 bytes) : Checksum of user boot MATs

The total of the data is obtained in byte units.

— SUM (1 byte) : Sum check for data being transmitted

- User-Program Sum check

The boot program will return the byte-by-byte total of the contents of the bytes of the user program.

Command	H'4B

— Command, H'4B, (1 byte) : Sum check for user program

Response	H'5B	Size	Checksum of user program	SUM

— Response, H'5B, (1 byte) : Response to the sum check of the user program

— Size (1 byte) : The number of bytes that represents the checksum
This is fixed to 4.

— Checksum of user boot program (4 bytes) : Checksum of user MATs
The total of the data is obtained in byte units.

— SUM (1 byte) : Sum check for data being transmitted

- User Boot MAT Blank check

The boot program will check whether or not all user boot MATs are blank and return the result.

Command	H'4C

— Command, H'4C, (1 byte) : Blank check for user boot MAT

Response	H'06

— Response, H'06, (1 byte) : Response to the blank check of user boot MAT
If all user MATs are blank (H'FF), the boot program will return ACK.

Error response	H'CC	H'52

— Error Response, H'CC, (1 byte) : Response to blank check for user boot MAT

— Error Code, H'52, (1 byte) : Erasure has not been completed.

- User MAT Blank Check

The boot program will check whether or not all user MATs are blank and return the result.

Command	H'4D

— Command, H'4D, (1 byte) : Blank check for user MATs

Response	H'06

— Response, H'06, (1 byte) : Response to the blank check for user boot MATs
If the contents of all user MATs are blank (H'FF), the boot program will return ACK.

Error response		
	H'CD	H'52

— Error Response, H'CD, (1 byte) : Error response to the blank check of user MATs.

— Error codeH'52 (1 byte) : Erasure has not been completed.

- Boot Program State Inquiry

The boot program will return indications of its present state and error condition. This inquiry can be made in the inquiry/selection state or the programming/erasing state.

Command	
	H'4F

— Command, H'4F, (1 byte) : Inquiry regarding boot program's state

Response					
	H'5F	Size	STATUS	ERROR	SUM

— Response, H'5F, (1 byte) : Response to boot program state inquiry

— Size (1 byte) : The number of bytes that represents the STATUS and ERROR.
This is fixed to 2.

— STATUS (1 byte) : State of the boot program
For details, see table 18.18.

— ERROR (1 byte): Error state
ERROR = 0 indicates normal operation.
ERROR = 1 indicates error has occurred
For details, see table 18.19.

— SUM (1 byte): Checksum

Table 18.18 Status Code

Code	Description
H'11	Device Selection Wait
H'12	Clock Mode Selection Wait
H'13	Bit Rate Selection Wait
H'1F	Programming/Erasing State Transition Wait (Bit rate selection is completed)
H'31	Programming State for Erasure
H'3F	Programming/Erasing Selection Wait (Erasure is completed)
H'4F	Programming Data Receive Wait (Programming is completed)
H'5F	Erasure Block Specification Wait (Erasure is completed)

Table 18.19 Error Code

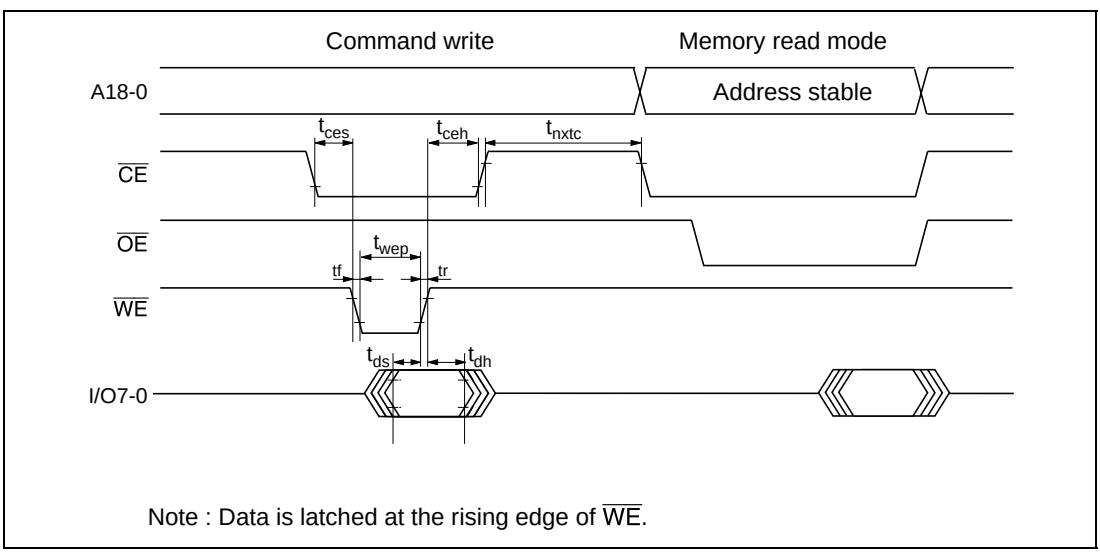
Code	Description
H'00	No Error
H'11	Sum Check Error
H'12	Program Size Error
H'21	Device Code Mismatch Error
H'22	Clock Mode Mismatch Error
H'24	Bit Rate Selection Error
H'25	Input Frequency Error
H'26	Multiplication Ratio Error
H'27	Operating Frequency Error
H'29	Block Number Error
H'2A	Address Error
H'2B	Data Length Error
H'51	Erasure Error
H'52	Erasure Incompletion Error
H'53	Programming Error
H'54	Selection Error
H'80	Command Error
H'FF	Bit-Rate-Adjustment Confirmation Error

18.10.2 AC Characteristics and Timing in Writer Mode

Table 18.20 AC Characteristics in Memory Read Mode

Condition : V_{CC} = 5.0 V ± 0.5 V, V_{SS} = 0 V, T_a = 25°C ± 5°C

Code	Symbol	Min	Max	Unit	Note
Command write cycle	t_{nxtc}	20		µs	
$\overline{CE}$ hold time	t_{ceh}	0		ns	
$\overline{CE}$ setup time	t_{ces}	0		ns	
Data hold time	t_{dh}	50		ns	
Data setup time	t_{ds}	50		ns	
Programming pulse width	t_{wep}	70		ns	
$\overline{WE}$ rise time	t_r		30	ns	
$\overline{WE}$ fall time	t_f		30	ns	



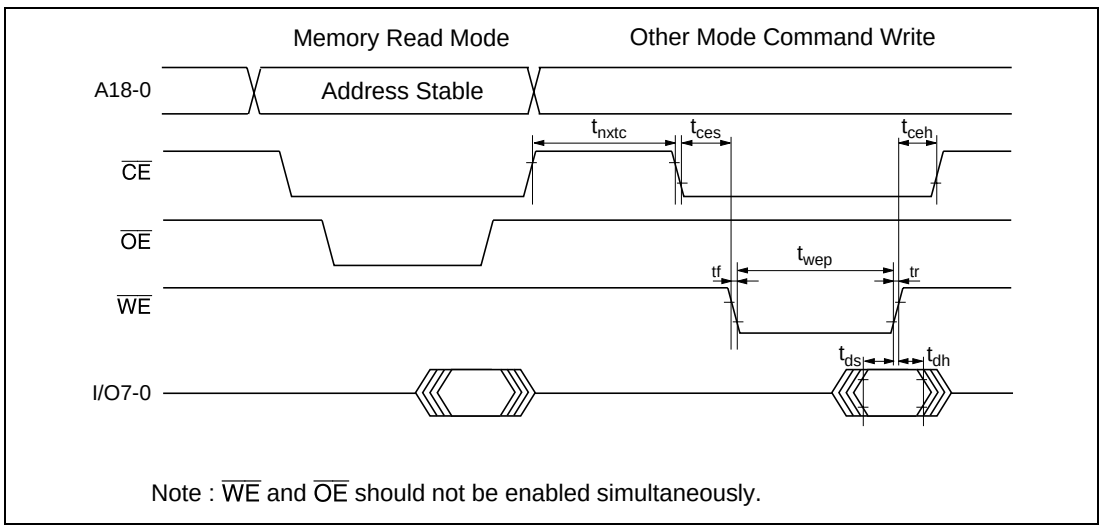
Note : Data is latched at the rising edge of $\overline{WE}$.

Figure 18.29 Memory Read Timing after Command Write

Table 18.21 AC Characteristics in Transition from Memory Read Mode to Others

Condition : V_{CC} = 5.0 V ± 0.5 V, V_{SS} = 0 V, T_a = 25°C ± 5°C

Code	Symbol	Min	Max	Unit	Note
Command write cycle	t_{nxtc}	20		µs	
$\overline{CE}$ hold time	t_{ceh}	0		ns	
$\overline{CE}$ setup time	t_{ces}	0		ns	
Data hold time	t_{dh}	50		ns	
Data setup time	t_{ds}	50		ns	
Programming pulse width	t_{wep}	70		ns	
$\overline{WE}$ rise time	t_r		30	ns	
$\overline{WE}$ fall time	t_f		30	ns	



Note : $\overline{WE}$ and $\overline{OE}$ should not be enabled simultaneously.

Figure 18.30 Timing at Transition from Memory Read Mode to Other Modes

Table 18.22 AC Characteristics Memory Read Mode

Condition : V_{CC} = 5.0 V ± 0.5 V, V_{SS} = 0 V, T_a = 25°C ± 5°C

Code	Symbol	Min	Max	Unit	Note
Access time	t_{acc}		20	µs	
$\overline{CE}$ output delay time	t_{ce}		150	ns	
$\overline{OE}$ output delay time	t_{oe}		150	ns	
Output disable delay time	t_{df}		100	ns	
Data output hold time	t_{oh}	5		ns	

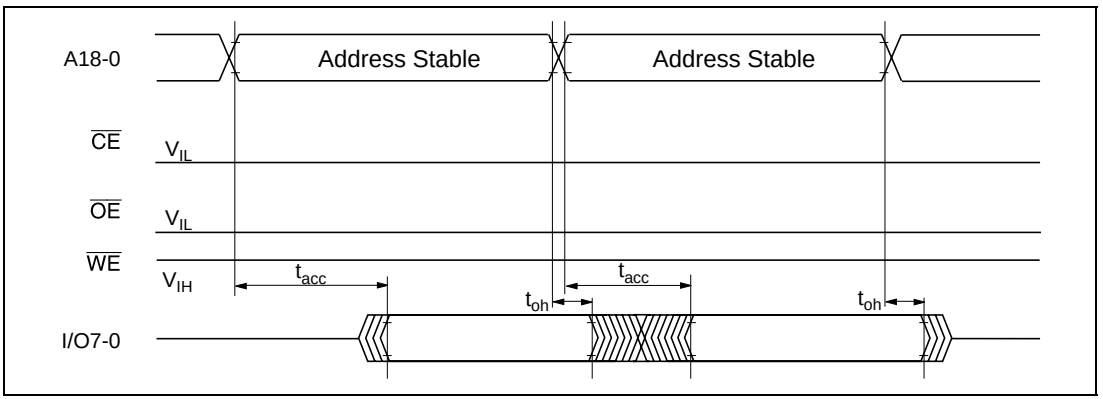


Figure 18.31 $\overline{CE}$/$\overline{OE}$ Enable State Read

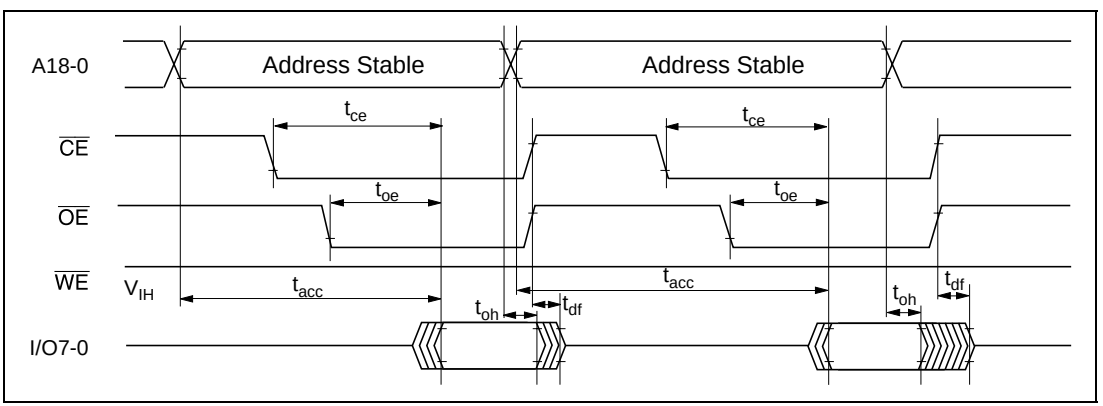


Figure 18.32 $\overline{CE}$/$\overline{OE}$ Clock Read

Table 18.23 AC Characteristics Auto-Write Mode

Condition : V_{CC} = 5.0 V ± 0.5 V, V_{SS} = 0 V, T_a = 25°C ± 5°C

Code	Symbol	Min	Max	Unit	Note
Command write cycle	t_{nxtc}	20		µs	
$\overline{CE}$ hold time	t_{ceh}	0		ns	
$\overline{CE}$ setup time	t_{ces}	0		ns	
Data hold time	t_{dh}	50		ns	
Data setup time	t_{ds}	50		ns	
Programming pulse width	t_{wep}	70		ns	
Status polling start time	t_{wsts}	1		ms	
Status polling access time	t_{spa}		150	ns	
Address setup time	t_{as}	0		ns	
Address hold time	t_{ah}	60		ns	
Memory programming time	t_{write}	1	3000	ms	
Programming setup time	t_{pns}	100		ns	
Programming end setup time	t_{pnh}	100		ns	
$\overline{WE}$ rise time	t_r		30	ns	
$\overline{WE}$ fall time	t_f		30	ns	

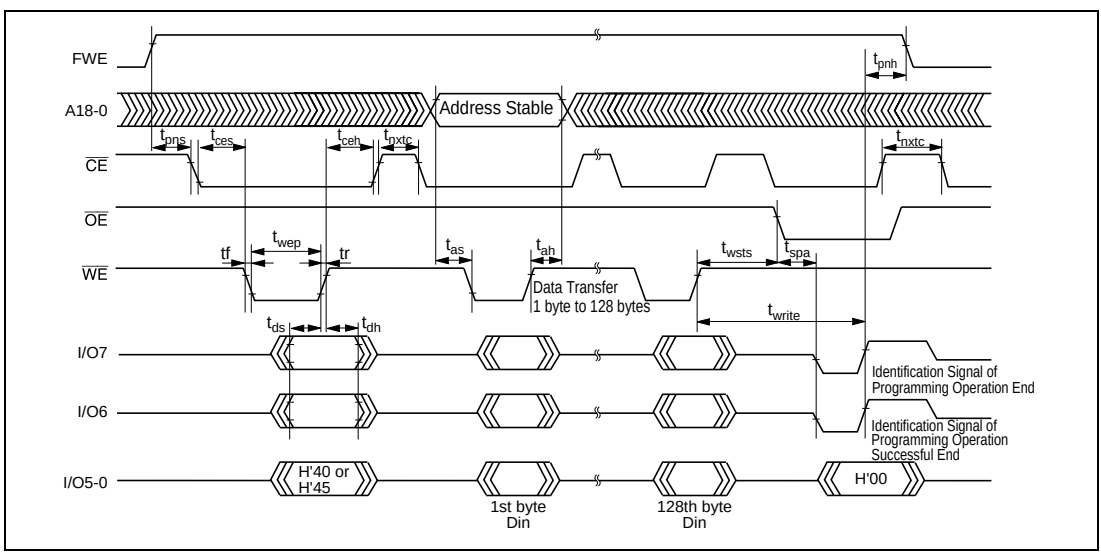


Figure 18.33 Timing in Auto-Write Mode

Table 18.24 AC Characteristics Auto-Erase Mode

Condition : V_{CC} = 5.0 V ± 0.5 V, V_{SS} = 0 V, T_a = 25°C ± 5°C

Code	Symbol	Min	Max	Unit	Note
Command write cycle	t_{nxtc}	20		µs	
$\overline{CE}$ hold time	t_{ceh}	0		ns	
$\overline{CE}$ setup time	t_{ces}	0		ns	
Data hold time	t_{dh}	50		ns	
Data setup time	t_{ds}	50		ns	
Programming pulse width	t_{wep}	70		ns	
Status polling start time	t_{ests}	1		ms	
Status polling access time	t_{spa}		150	ns	
Memory erase time	t_{erase}	100	40000	ms	
Erase setup time	t_{ens}	100		ns	
Erase end setup time	t_{enh}	100		ns	
$\overline{WE}$ rise time	t_r		30	ns	
$\overline{WE}$ fall time	t_f		30	ns	

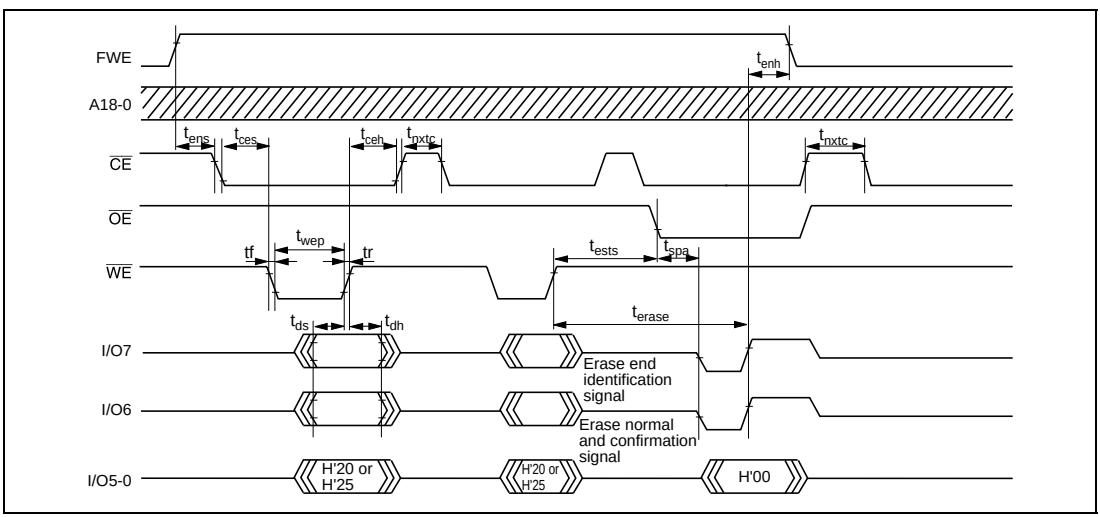
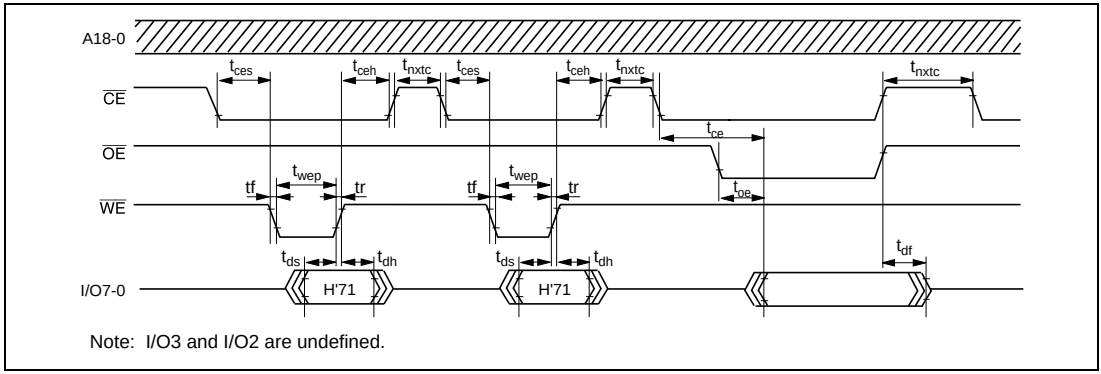


Figure 18.34 Timing in Auto-Erase Mode

Table 18.25 AC Characteristics Status Read Mode

Condition : V_{CC} = 5.0 V ± 0.5 V, V_{SS} = 0 V, T_a = 25°C ± 5°C

Code	Symbol	Min	Max	Unit	Note
Command write cycle	t_{nxtc}	20		µs	
$\overline{CE}$ hold time	t_{ceh}	0		ns	
$\overline{CE}$ setup time	t_{ces}	0		ns	
Data hold time	t_{dh}	50		ns	
Data setup time	t_{ds}	50		ns	
Programming pulse width	t_{wep}	70		ns	
$\overline{OE}$ output delay time	t_{oe}		150	ns	
Disable delay time	t_{df}		100	ns	
$\overline{CE}$ output delay time	t_{ce}		150	ns	
$\overline{WE}$ rise time	t_r		30	ns	
$\overline{WE}$ fall time	t_f		30	ns	



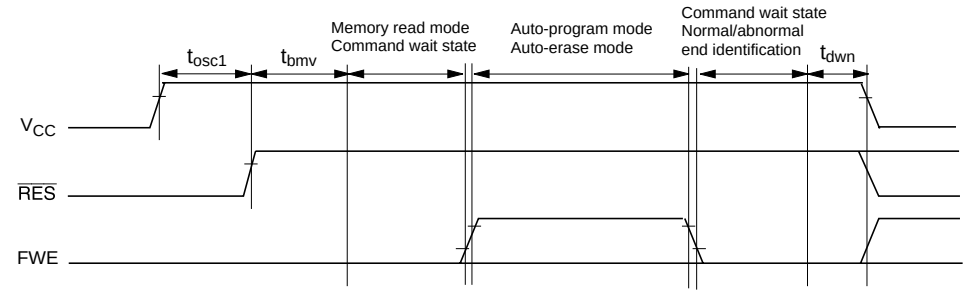
Note: I/O3 and I/O2 are undefined.

Figure 18.35 Timing in Status Read Mode

Table 18.26 Stipulated Transition Times to Command Wait State

Condition : V_{CC} = 5.0 V ± 0.5 V, V_{SS} = 0 V, T_a = 25°C ± 5°C

Code	Symbol	Min	Max	Unit	Note
Standby release (oscillation settling time)	t_{osc1}	30		ms	
PROM mode setup time	t_{bmv}	10		ms	
V_{CC} hold time	t_{dwn}	0		ms	



Note: Set the FWE input pin low level, except in the auto-program and auto-erase modes.

Figure 18.36 Oscillation Stabilization Time, PROM Mode Setup Time, and Power-Down Sequence

18.10.3 Procedure Program and Storable Area for Programming Data

In the descriptions in the previous section, the programming/erasing procedure programs and storable areas for program data are assumed to be in the on-chip RAM. However, the program and the data can be stored in and executed from other areas, such as part of flash memory which is not to be programmed or erased, or somewhere in the external address space.

- Conditions that Apply to Programming/Erasing

(1) The on-chip programming/erasing program is downloaded from the address set by FTDAR in on-chip RAM, therefore, this area is not available for use.

(2) The on-chip programming/erasing program will use the 128 bytes as a stack. So, make sure that this area is secured.

(3) Since download by setting the SCO bit to 1 will cause the MATs to be switched, it should be executed in on-chip RAM.

(4) The flash memory is accessible until the start of programming or erasing, that is, until the result of downloading has been judged. When in a mode in which the external address space is not accessible, such as single-chip mode, the required procedure programs, NMI handling vector, NMI handler and user branch program should be transferred to the on-chip RAM before programming/erasing of the flash memory starts.

(5) The flash memory is not accessible during programming/erasing operations, therefore, the operation program is downloaded to the on-chip RAM to be executed. The NMI-handling vector and programs such as that which activate the operation program, user program at the user-branch destination during programming/erasing operation, and NMI handler should thus be stored in on-chip memory other than flash memory or the external address space.

(6) After programming/erasing, the flash memory should be inhibited until FKEY is cleared. The reset state ($\overline{RES}$ = 0) must be in place for more than 100 µs when the LSI mode is changed to reset on completion of a programming/erasing operation.

Transitions to the reset state, and hardware standby mode are inhibited during programming/erasing. When the reset signal is accidentally input to the chip, a longer period in the reset state than usual (100 μs) is needed before the reset signal is released.

(7) Switching of the MATs by FMATS should be needed when programming/erasing of the user boot MAT is operated in user-boot mode. The program which switches the MATs should be executed from the on-chip RAM. See section 18.8, Switching between User MAT and User Boot MAT. Please make sure you know which MAT is selected when switching between them.

(8) When the data storable area indicated by programming parameter FMPDR is within the flash memory area, an error will occur even when the data stored is normal. Therefore, the data should be transferred to the on-chip RAM to place the address that FMPDR indicates in an area other than the flash memory.

In consideration of these conditions, there are three factors; operating mode, the bank structure of the user MAT, and operations.

The areas in which the programming data can be stored for execution are shown in table 18.27.

Table 18.27 Executable MAT

	Initiated Mode	
Operation	**User Program Mode**	**User Boot Mode***
Programming	Table 18.28 (1)	Table 18.28 (3)
Erasing	Table 18.28 (2)	Table 18.28 (4)

Note: * Programming/Erasing is possible to user MATs.

Table 18.28 (1) Useable Area for Programming in User Program Mode

		Storable /Executable Area			Selected MAT	
	Item	On-chip RAM	User MAT	External Space (Expanded Mode)	User MAT	Embedded Program Storage Area
Programming Procedure	Storage Area for Program Data	○	×*	○	—	—
	Operation for Selection of On-chip Program to be Downloaded	○	○	○	○	
	Operation for Writing H'A5 to Key Register	○	○	○	○	
	Execution of Writing SC0 = 1 to FCCS (Download)	○	×	×		○
	Operation for Key Register Clear	○	○	○	○	
	Judgement of Download Result	○	○	○	○	
	Operation for Download Error	○	○	○	○	
Operation for Settings of Initial Parameter		○	○	○	○	
Execution of Initialization		○	×	×	○	
Judgement of Initialization Result		○	○	○	○	
Operation for Initialization Error		○	○	○	○	

Item	Storable /Executable Area			Selected MAT	
	On-chip RAM	User MAT	External Space (Expanded Mode)	User MAT	Embedded Program Storage Area
NMI Handling Routine	○	×	○	○	
Operation for Inhibit of Interrupt	○	○	○	○	
Operation for Writing H'5A to Key Register	○	○	○	○	
Operation for Settings of Program Parameter	○	×	○	○	
Execution of Programming	○	×	×	○	
Judgement of Program Result	○	×	○	○	
Operation for Program Error	○	×	○	○	
Operation for Key Register Clear	○	×	○	○	

Note: * Transferring the data to the on-chip RAM enables this area to be used.

Table 18.28 (2) Useable Area for Erasure in User Program Mode

		Storable /Executable Area			Selected MAT	
	Item	On-chip RAM	User MAT	External Space (Expanded Mode)	User MAT	Embedded Program Storage Area
Erasing Procedure	Operation for Selection of On-chip Program to be Downloaded	○	○	○	○	
	Operation for Writing H'A5 to Key Register	○	○	○	○	
	Execution of Writing SC0 = 1 to FCCS (Download)	○	×	×		○
	Operation for Key Register Clear	○	○	○	○	
	Judgement of Download Result	○	○	○	○	
Operation for Download Error		○	○	○	○	
Operation for Settings of Default Parameter		○	○	○	○	
Execution of Initialization		○	×	×	○	
Judgement of Initialization Result		○	○	○	○	
Operation for Initialization Error		○	○	○	○	
NMI Handling Routine		○	×	○	○	

Item	Storable /Executable Area			Selected MAT	
	On-chip RAM	User MAT	External Space (Expanded Mode)	User MAT	Embedded Program Storage Area
Operation for Inhibit of Interrupt	○	○	○	○	
Operation for Writing H'5A to Key Register	○	○	○	○	
Operation for Settings of Erasure Parameter	○	×	○	○	
Execution of Erasure	○	×	×	○	
Judgement of Erasure Result	○	×	○	○	
Operation for Erasure Error	○	×	○	○	
Operation for Key Register Clear	○	×	○	○	

Table 18.28 (3) Useable Area for Programming in User Boot Mode

		Storable/Executable Area			Selected MAT		
	Item	On-chip RAM	User Boot MAT	External Space (Expanded Mode)	User MAT	User Boot MAT	Embedded Program Storage Area
Programming procedure	Storage Area for Program Data	○	×*[1]	○	—	—	—
	Operation for Selection of On-chip Program to be Downloaded	○	○	○		○	
	Operation for Writing H'A5 to Key Register	○	○	○		○	
	Execution of Writing SC0 = 1 to FCCS (Download)	○	×	×			○
	Operation for Key Register Clear	○	○	○		○	
	Judgement of Download Result	○	○	○		○	
	Operation for Download Error	○	○	○		○	
Operation for Settings of Default Parameter		○	○	○		○	
Execution of Initialization		○	×	×		○	
Judgement of Initialization Result		○	○	○		○	
Operation for Initialization Error		○	○	○		○	
NMI Handling Routine		○	×	○		○	

Item	Storable/Executable Area			Selected MAT		
	On-chip RAM	User Boot MAT	External Space (Expanded Mode)	User MAT	User Boot MAT	Embedded Program Storage Area
Operation for Interrupt Inhibit	○	○	○		○	
Switching MATs by FMATS	○	×	×	○		
Operation for Writing H'5A to Key Register	○	×	○	○		
Operation for Settings of Program Parameter	○	×	○	○		
Execution of Programming	○	×	×	○		
Judgement of Program Result	○	×	○	○		
Operation for Program Error	○	×*[2]	○	○		
Operation for Key Register Clear	○	×	○	○		
Switching MATs by FMATS	○	×	×		○	

Notes: 1. Transferring the data to the on-chip RAM enables this area to be used.
2. Switching FMATS by a program in the on-chip RAM enables this area to be used.

Table 18.28 (4) Useable Area for Erasure in User Boot Mode

		Storable/Executable Area			Selected MAT		
	Item	On-chip RAM	User Boot MAT	External Space (Expanded Mode)	User MAT	User Boot MAT	Embedded Program Storage Area
Erasing Procedure	Operation for Selection of On-chip Program to be Downloaded	○	○	○		○	
	Operation for Writing H'A5 to Key Register	○	○	○		○	
	Execution of Writing SC0 = 1 to FCCS (Download)	○	×	×			○
	Operation for Key Register Clear	○	○	○		○	
	Judgement of Download Result	○	○	○		○	
Operation for Download Error		○	○	○		○	
Operation for Settings of Default Parameter		○	○	○		○	
Execution of Initialization		○	×	×		○	
Judgement of Initialization Result		○	○	○		○	
Operation for Initialization Error		○	○	○		○	
NMI Handling Routine		○	×	○		○	

Item	Storable/Executable Area			Selected MAT		
	On-chip RAM	User Boot MAT	External Space (Expanded Mode)	User MAT	User Boot MAT	Embedded Program Storage Area
Operation for Interrupt Inhibit	○	○	○		○	
Switching MATs by FMATS	○	×	×	○		
Operation for Writing H'5A to Key Register	○	×	○	○		
Operation for Settings of Erasure Parameter	○	×	○	○		
Execution of Erasure	○	×	×	○		
Judgement of Erasure Result	○	×	○	○		
Operation for Erasure Error	○	×*	○	○		
Operation for Key Register Clear	○	×	○	○		
Switching MATs by FMATS	○	×	×		○	

Note: * Switching FMATS by a program in the on-chip RAM enables this area to be used.

Section 19 Clock Pulse Generator

19.1 Overview

The H8/3069R has a built-in clock pulse generator (CPG) that generates the system clock (φ) and other internal clock signals (φ/2 to φ/4096). After duty adjustment, a frequency divider divides the clock frequency to generate the system clock (φ). The system clock is output at the φ pin*[1] and furnished as a master clock to prescalers that supply clock signals to the on-chip supporting modules. Frequency division ratios of 1/1, 1/2, 1/4, and 1/8 can be selected for the frequency divider by settings in a division control register (DIVCR)*[2]. Power consumption in the chip is reduced in almost direct proportion to the frequency division ratio.

Notes: 1. Usage of the φ pin differs depending on the chip operating mode and the PSTOP bit setting in the module standby control register (MSTCR). For details, see section 20.7, System Clock Output Disabling Function.

2. The division ratio of the frequency divider can be changed dynamically during operation. The clock output at the φ pin also changes when the division ratio is changed. The frequency output at the φ pin is shown below.

$$\phi = \mathrm{EXTAL} \times n$$

where, EXTAL: Frequency of crystal resonator or external clock signal

n: Frequency division ratio (n = 1/1, 1/2, 1/4, or 1/8)

19.1.1 Block Diagram

Figure 19.1 shows a block diagram of the clock pulse generator.

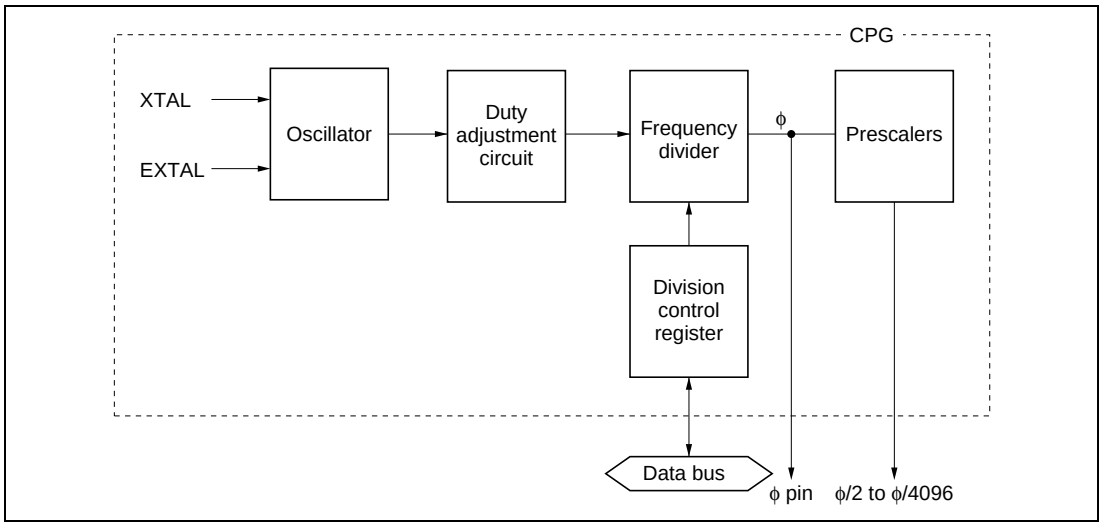


Figure 19.1 Block Diagram of Clock Pulse Generator

19.2 Oscillator Circuit

Clock pulses can be supplied by connecting a crystal resonator, or by input of an external clock signal.

19.2.1 Connecting a Crystal Resonator

Circuit Configuration: A crystal resonator can be connected as in the example in figure 19.2. Damping resistance Rd should be selected according to table 19.1 (1), and external capacitances C_{L1} and C_{L2} according to table 19.1 (2). An AT-cut parallel-resonance crystal should be used.

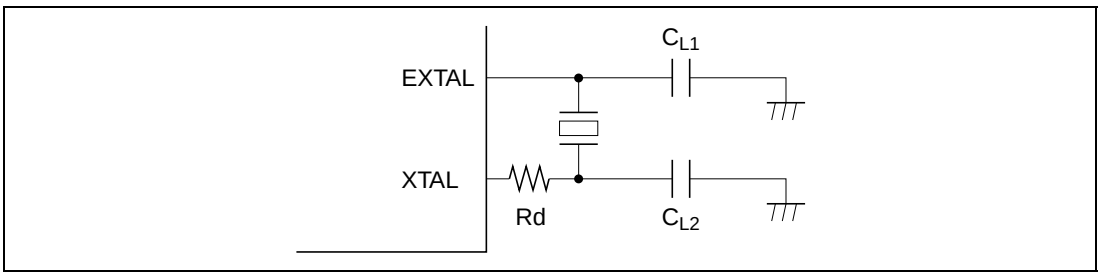


Figure 19.2 Connection of Crystal Resonator (Example)

If a crystal resonator with a frequency higher than 20 MHz is connected, the external load capacitance values in table 19.1 (2) should not exceed 10 pF. Also, in order to improve the accuracy of the oscillation frequency, a thorough study of oscillation matching evaluation, etc., should be carried out when deciding the circuit constants.

Table 19.1 (1) Damping Resistance Value

Damping Resistance Value	Frequency f (MHz)			
	10 ≤ f ≤ 13	**13 < f ≤ 16**	**16 < f ≤ 18**	**18 < f ≤ 25**
Rd (Ω)	0	0	0	0

Note: A crystal resonator between 10 MHz and 25 MHz can be used. If the chip is to be operated at less than 10 MHz, the on-chip frequency divider should be used. (A crystal resonator of less than 10 MHz cannot be used.)

Table 19.1 (2) External Capacitance Values

	Frequency f (MHz)	
External Capacitance Value	**20 < f ≤ 25**	**10 ≤ f ≤ 20**
$C_{L1} = C_{L2}$ (pF)	10	10 to 22

Crystal Resonator: Figure 19.3 shows an equivalent circuit of the crystal resonator. The crystal resonator should have the characteristics listed in table 19.2.

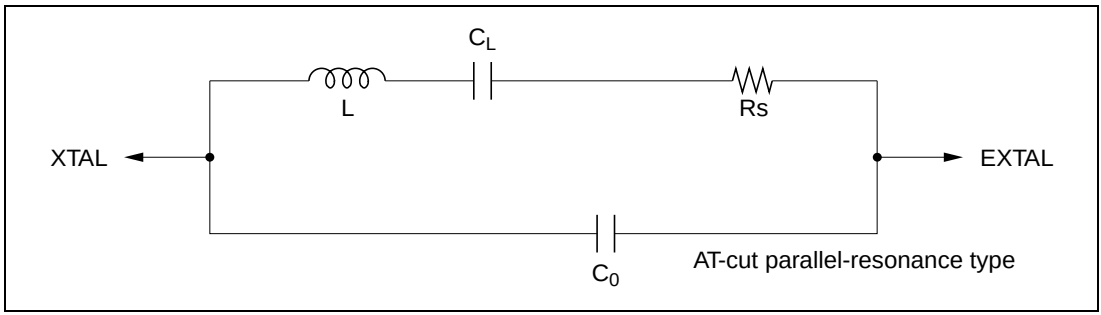


Figure 19.3 Crystal Resonator Equivalent Circuit

Table 19.2 Crystal Resonator Parameters

Frequency (MHz)	10	12	16	18	20	25
Rs max (Ω)	30	30	20	20	20	20
Co (pF)	7 (max)	7 (max)	7 (max)	7 (max)	7 (max)	7 (max)

Use a crystal resonator with a frequency equal to the system clock frequency (ϕ).

Notes on Board Design: When a crystal resonator is connected, the following points should be noted:

Other signal lines should be routed away from the oscillator circuit to prevent induction from interfering with correct oscillation. See figure 19.4.

When the board is designed, the crystal resonator and its load capacitors should be placed as close as possible to the XTAL and EXTAL pins.

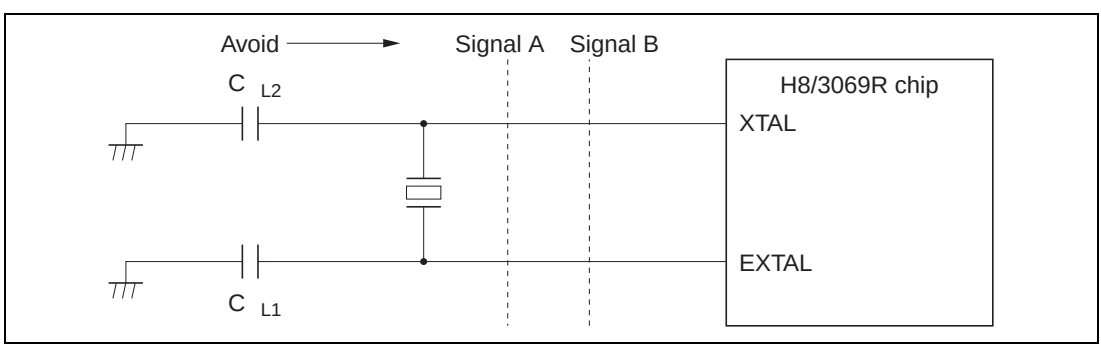


Figure 19.4 Oscillator Circuit Block Board Design Precautions

19.2.2 External Clock Input

When the external clock signal is input to the EXTAL pin, the counter-phase clock signal should be input to the XTAL pin as shown in figure 19.5 (a). However, the external clock should go high in standby mode.

When the XTAL pin is left open, the foot pattern on the board should be formed as small as possible and wiring should not be done on the printed-circuit board in order to make the stray capacitance at the XTAL pin be the minimum value.

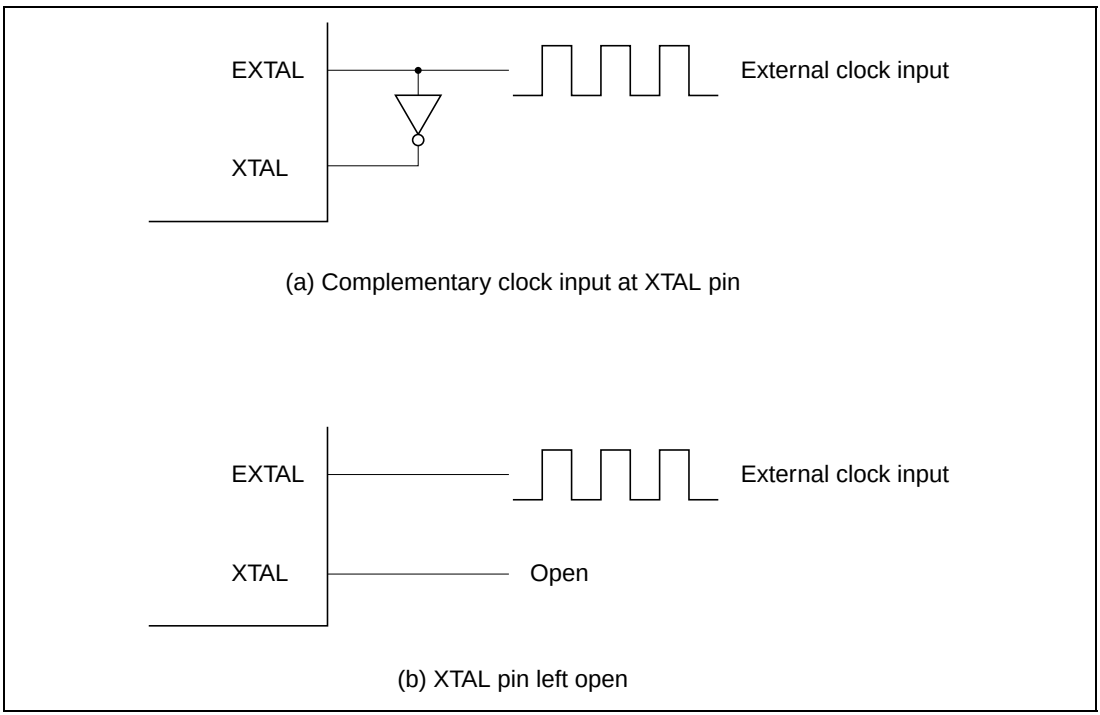


Figure 19.5 External Clock Input (Examples)

External Clock: The external clock frequency should be equal to the system clock frequency when not divided by the on-chip frequency divider. Table 19.3 shows the clock timing, figure 19.6 shows the external clock input timing, and figure 19.7 shows the external clock output settling delay timing. When the appropriate external clock is input via the EXTAL pin, its waveform is corrected by the on-chip oscillator and duty adjustment circuit.

When the appropriate external clock is input via the EXTAL pin, its waveform is corrected by the on-chip oscillator and duty adjustment circuit. The resulting stable clock is output to external devices after the external clock settling time (t_{DEXT}) has passed after the clock input. The system must remain reset with the reset signal low during t_{DEXT}, while the clock output is unstable.

Table 19.3 Clock Timing

		V_{cc} = 5.0 V ± 10%			
Item	**Symbol**	**Min**	**Max**	**Unit**	**Test Conditions**
External clock input low pulse width	t_{EXL}	15	—	ns	Figure 19.6
External clock input high pulse width	t_{EXH}	15	—	ns	
External clock rise time	t_{EXr}	—	5	ns	
External clock fall time	t_{EXf}	—	5	ns	
Clock low pulse width	t_{CL}	0.4	0.6	t_{cyc}	Figure 21.13
Clock high pulse width	t_{CH}	0.4	0.6	t_{cyc}	
External clock output settling delay time	t_{DEXT}*	500	—	µs	Figure 19.7

Note: * t_{DEXT} includes a $\overline{RES}$ pulse width (t_{RESW}). t_{RESW} = 20 t_{cyc}

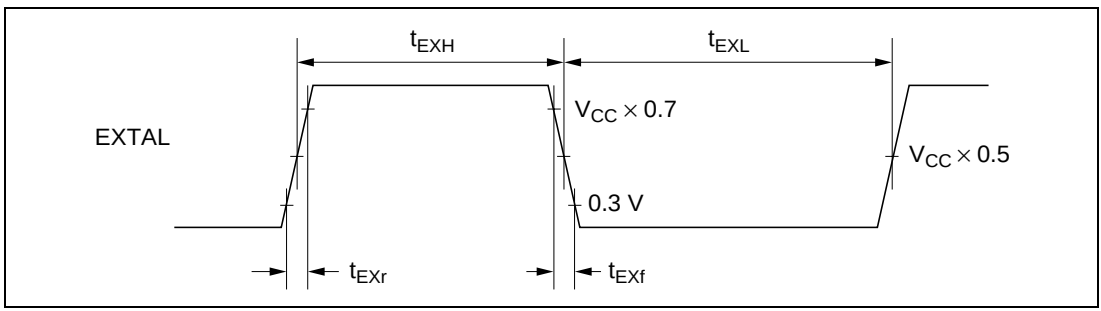


Figure 19.6 External Clock Input Timing

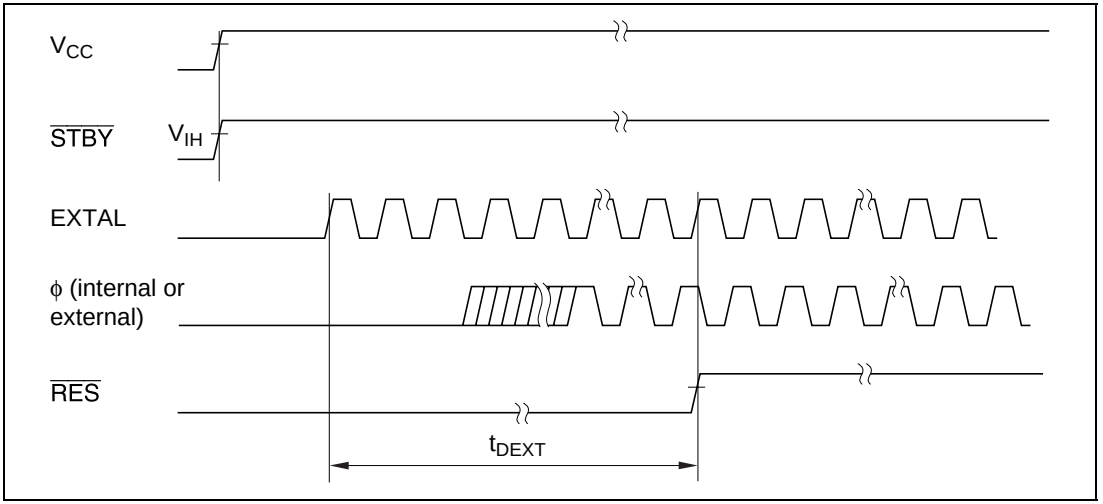


Figure 19.7 External Clock Output Settling Delay Timing

19.3 Duty Adjustment Circuit

The duty adjustment circuit adjusts the duty cycle of the clock signal from the oscillator to generate ϕ.

19.4 Prescalers

The prescalers divide the system clock (ϕ) to generate internal clocks (ϕ/2 to ϕ/4096).

19.5 Frequency Divider

The frequency divider divides the duty-adjusted clock signal to generate the system clock (ϕ). The frequency division ratio can be changed dynamically by modifying the value in DIVCR, as described below. Power consumption in the chip is reduced in almost direct proportion to the frequency division ratio. The system clock generated by the frequency divider can be output at the ϕ pin.

19.5.1 Register Configuration

Table 19.4 summarizes the frequency division register.

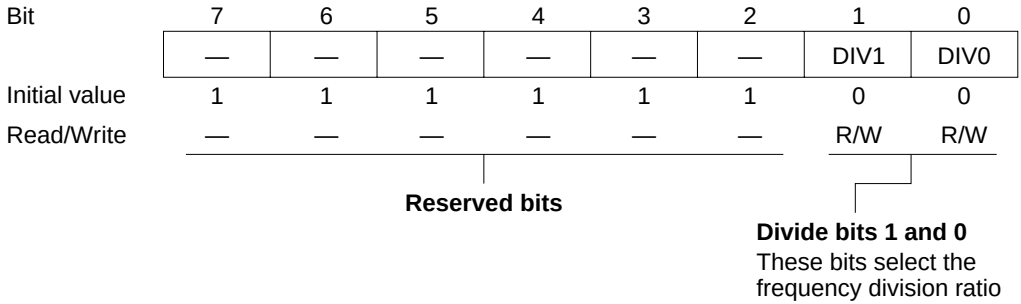
Table 19.4 Frequency Division Register

Address*	Name	Abbreviation	R/W	Initial Value
H'EE01B	Division control register	DIVCR	R/W	H'FC

Note: * Lower 20 bits of the address in advanced mode.

19.5.2 Division Control Register (DIVCR)

DIVCR is an 8-bit readable/writable register that selects the division ratio of the frequency divider.



DIVCR is initialized to H'FC by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bits 7 to 2—Reserved: These bits cannot be modified and are always read as 1.

Bits 1 and 0—Divide (DIV1, DIV0): These bits select the frequency division ratio, as follows.

Bit 1 DIV1	Bit 0 DIV0	Frequency Division Ratio	
0	0	1/1	(Initial value)
0	1	1/2	
1	0	1/4	
1	1	1/8	

19.5.3 Usage Notes

The DIVCR setting changes the ϕ frequency, so note the following points.

- Select a frequency division ratio that stays within the assured operation range specified for the clock cycle time t_{cyc} in the AC electrical characteristics. Note that ϕ_{min} = lower limit of the operating frequency range. Ensure that ϕ is not below this lower limit.
- All on-chip module operations are based on ϕ. Note that the timing of timer operations, serial communication, and other time-dependent processing differs before and after any change in the division ratio. The waiting time for exit from software standby mode also changes when the division ratio is changed. For details, see section 20.4.3, Selection of Waiting Time for Exit from Software Standby Mode.

Section 20 Power-Down State

20.1 Overview

The H8/3069R has a power-down state that greatly reduces power consumption by halting the CPU, and a module standby function that reduces power consumption by selectively halting on-chip modules.

The power-down state includes the following three modes:

- Sleep mode
- Software standby mode
- Hardware standby mode

The module standby function can halt on-chip supporting modules independently of the power-down state. The modules that can be halted are the 16-bit timer, 8-bit timer, SCI0, SCI1, SCI2, DMAC, DRAM interface, and A/D converter.

Table 20.1 indicates the methods of entering and exiting the power-down modes and module standby mode, and gives the status of the CPU and on-chip supporting modules in each mode.

Mode	Entering Conditions	State: Clock	CPU	CPU Registers	DMAC	DRAM Interface	16-Bit Timer	8-Bit Timer	SCI0	SCI1	SCI2	A/D	Other Modules	RAM	φ clock output*4	I/O Ports	Exiting Conditions
Sleep mode	SLEEP instruction executed while SSBY = 0 in SYSCR	Active	Halted	Held	Active	Active	Active	Active	Active	Active	Active	Active	Active	Held	φ output	Held	• Interrupt • $\overline{\text{RES}}$ • $\overline{\text{STBY}}$
Software standby mode	SLEEP instruction executed while SSBY = 1 in SYSCR	Halted	Halted	Held	Halted and reset	Halted and held*1	Halted and reset	Halted and reset	Halted and reset	Halted and reset	Halted and reset	Halted and reset	Halted and reset	Held	High output	Held	• $\overline{\text{NMI}}$ • $\overline{\text{IRQ}}_0$ to $\overline{\text{IRQ}}_2$ • $\overline{\text{RES}}$ • $\overline{\text{STBY}}$
Hardware standby mode	Low input at $\overline{\text{STBY}}$ pin	Halted	Halted	Undetermined	Halted and reset	Halted and reset	Halted and reset	Halted and reset	Halted and reset	Halted and reset	Halted and reset	Halted and reset	Halted and reset	Held*3	High impedance	High impedance	• $\overline{\text{STBY}}$ • $\overline{\text{RES}}$
Module standby	Corresponding bit set to 1 in MSTCR	Active	Active	—	Halted*2 and reset	Halted*2 and held*1	Halted*2 and reset	Halted*2 and reset	Halted*2 and reset	Halted*2 and reset	Halted*2 and reset	Halted*2 and reset	Active	—	High impedance*2	—	• $\overline{\text{STBY}}$ • $\overline{\text{RES}}$ • Clear MSTCR bit to 0*5

Notes: 1. RTCNT and bits 7 and 6 of RTMCSR are initialized. Other bits and registers hold their previous states.
2. State in which the corresponding MSTCR bit was set to 1. For details see section 20.2.2, Module Standby Control Register H (MSTCRH) and section 20.2.3, Module Standby Control Register L (MSTCRL).
3. The RAME bit must be cleared to 0 in SYSCR before the transition from the program execution state to hardware standby mode.
4. When $P6_7$ is used as the φ output pin.
5. When a MSTCR bit is set to 1, the registers of the corresponding on-chip supporting module are initialized. To restart the module, first clear the MSTCR bit to 0, then set up the module registers again.

[Legend]
SYSCR: System control register
SSBY: Software standby bit
MSTCRH: Module standby control register H
MSTCRL: Module standby control register L

20.2 Register Configuration

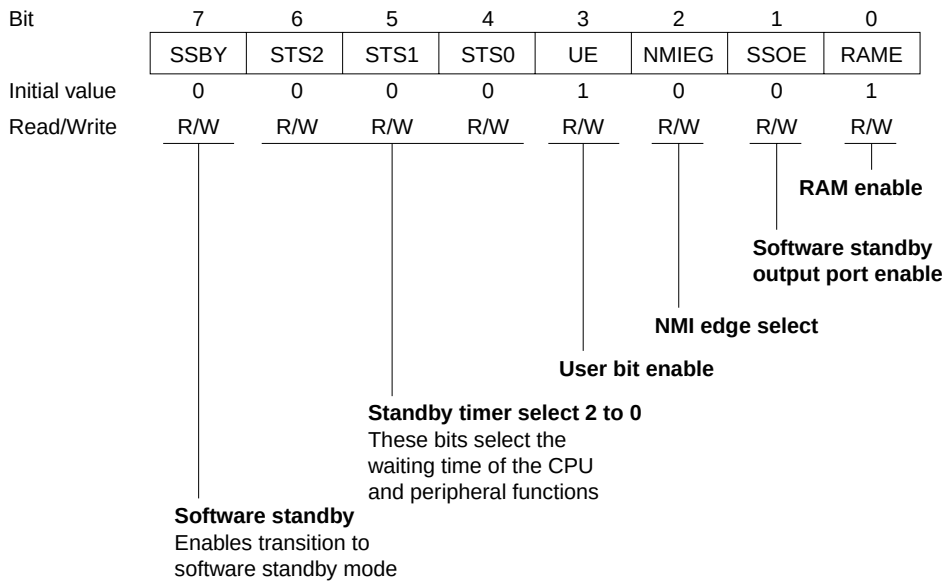
The H8/3069R has a system control register (SYSCR) that controls the power-down state, and module standby control registers H (MSTCRH) and L (MSTCRL) that control the module standby function. Table 20.2 summarizes these registers.

Table 20.2 Control Register

Address*	Name	Abbreviation	R/W	Initial Value
H'EE012	System control register	SYSCR	R/W	H'09
H'EE01C	Module standby control register H	MSTCRH	R/W	H'78
H'EE01D	Module standby control register L	MSTCRL	R/W	H'00

Note: * Lower 20 bits of the address in advanced mode.

20.2.1 System Control Register (SYSCR)



SYSCR is an 8-bit readable/writable register. Bit 7 (SSBY), bits 6 to 4 (STS2 to STS0), and bit 1 (SSOE) control the power-down state. For information on the other SYSCR bits, see section 3.3, System Control Register (SYSCR).

Bit 7—Software Standby (SSBY): Enables transition to software standby mode. When software standby mode is exited by an external interrupt, this bit remains set to 1 after the return to normal operation. To clear this bit, write 0.

Bit 7 SSBY	Description	
0	SLEEP instruction causes transition to sleep mode	(Initial value)
1	SLEEP instruction causes transition to software standby mode	

Bits 6 to 4—Standby Timer Select (STS2 to STS0): These bits select the length of time the CPU and on-chip supporting modules wait for the clock to settle when software standby mode is exited by an external interrupt. If the clock is generated by a crystal resonator, set these bits according to the clock frequency so that the waiting time will be at least 7 ms (oscillation settling time). See table 20.3. If an external clock is used, set these bits so that the waiting time will be at least 100 µs.

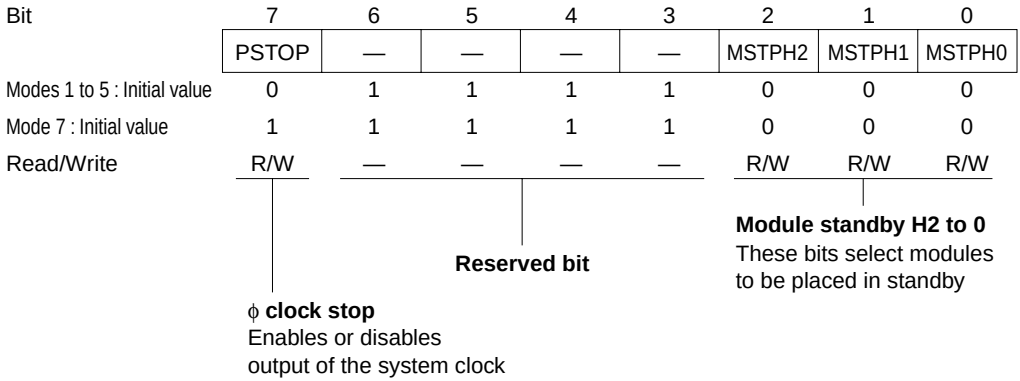
Bit 6 STS2	Bit 5 STS1	Bit 4 STS0	Description	
0	0	0	Waiting time = 8,192 states	(Initial value)
		1	Waiting time = 16,384 states	
	1	0	Waiting time = 32,768 states	
		1	Waiting time = 65,536 states	
1	0	0	Waiting time = 131,072 states	
		1	Waiting time = 262,144 states	
	1	0	Waiting time = 1,024 states	
		1	Illegal setting	

Bit 1—Software Standby Output Port Enable (SSOE): Specifies whether the address bus and bus control signals ($\overline{CS}_0$ to $\overline{CS}_7$, $\overline{AS}$, $\overline{RD}$, $\overline{HWR}$, $\overline{LWR}$, $\overline{UCAS}$, $\overline{LCAS}$, and $\overline{RFSH}$) are kept as outputs or fixed high, or placed in the high-impedance state in software standby mode.

Bit 1 SSOE	Description	
0	In software standby mode, the address bus and bus control signals are all high-impedance	(Initial value)
1	In software standby mode, the address bus retains its output state and bus control signals are fixed high	

20.2.2 Module Standby Control Register H (MSTCRH)

MSTCRH is an 8-bit readable/writable register that controls output of the system clock (ϕ). It also controls the module standby function, which places individual on-chip supporting modules in the standby state. Module standby can be designated for the SCI0, SCI1, SCI2.



In modes 1 to 5, MSTCRH is initialized to H'78 by a reset and in hardware standby mode, while in mode 7 it is initialized to H'F8. It is not initialized in software standby mode.

Bit 7—ϕ Clock Stop (PSTOP): Enables or disables output of the system clock (ϕ).

Bit 1 PSTOP	Description	
0	System clock output is enabled	(Initial value : When modes 1 to 5 are selected)
1	System clock output is disabled	(Initial value : When mode 7 is selected)

Bits 6 to 3—Reserved: These bits cannot be modified and are always read as 1.

Bit 2—Module Standby H2 (MSTPH2): Selects whether to place the SCI2 in standby.

Bit 2 MSTPH2	Description	
0	SCI2 operates normally	(Initial value)
1	SCI2 is in standby state	

Bit 1—Module Standby H1 (MSTPH1): Selects whether to place the SCI1 in standby.

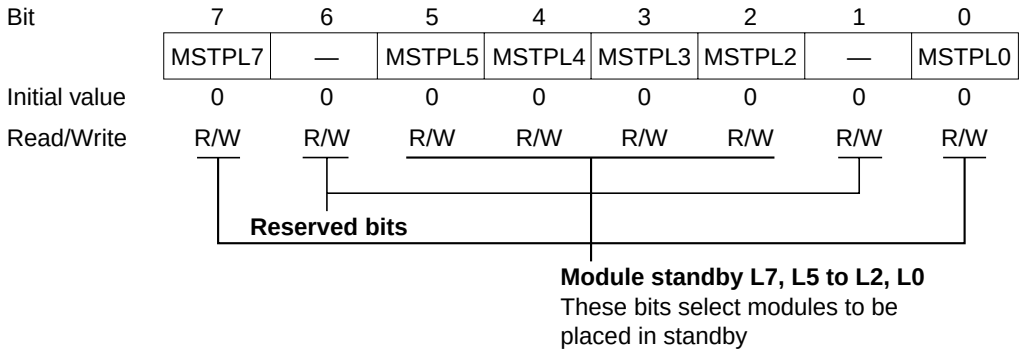
Bit 1 MSTPH1	Description	
0	SCI1 operates normally	(Initial value)
1	SCI1 is in standby state	

Bit 0—Module Standby H0 (MSTPH0): Selects whether to place the SCI0 in standby.

Bit 0 MSTPH0	Description	
0	SCI0 operates normally	(Initial value)
1	SCI0 is in standby state	

20.2.3 Module Standby Control Register L (MSTCRL)

MSTCRL is an 8-bit readable/writable register that controls the module standby function, which places individual on-chip supporting modules in the standby state. Module standby can be designated for the DMAC, 16-bit timer, DRAM interface, 8-bit timer, and A/D converter modules.



MSTCRL is initialized to H'00 by a reset and in hardware standby mode. It is not initialized in software standby mode.

Bit 7—Module Standby L7 (MSTPL7): Selects whether to place the DMAC in standby.

Bit 7 MSTPL7	Description	
0	DMAC operates normally	(Initial value)
1	DMAC is in standby state	

Bit 6—Reserved: This bit can be written and read.

Bit 5—Module Standby L5 (MSTPL5): Selects whether to place the DRAM interface in standby.

Bit 5 MSTPL5	Description	
0	DRAM interface operates normally	(Initial value)
1	DRAM interface is in standby state	

Bit 4—Module Standby L4 (MSTPL4): Selects whether to place the 16-bit timer in standby.

Bit 4 MSTPL4	Description	
0	16-bit timer operates normally	(Initial value)
1	16-bit timer is in standby state	

Bit 3—Module Standby L3 (MSTPL3): Selects whether to place 8-bit timer channels 0 and 1 in standby.

Bit 3 MSTPL3	Description	
0	8-bit timer channels 0 and 1 operate normally	(Initial value)
1	8-bit timer channels 0 and 1 are in standby state	

Bit 2—Module Standby L2 (MSTPL2): Selects whether to place 8-bit timer channels 2 and 3 in standby.

Bit 2 MSTPL2	Description	
0	8-bit timer channels 2 and 3 operate normally	(Initial value)
1	8-bit timer channels 2 and 3 are in standby state	

Bit 1—Reserved: This bit can be written and read.

Bit 0—Module Standby L0 (MSTPL0): Selects whether to place the A/D converter in standby.

Bit 0 MSTPL0	Description	
0	A/D converter operates normally	(Initial value)
1	A/D converter is in standby state	

20.3 Sleep Mode

20.3.1 Transition to Sleep Mode

When the SSBY bit is cleared to 0 in SYSCR, execution of the SLEEP instruction causes a transition from the program execution state to sleep mode. Immediately after executing the SLEEP instruction the CPU halts, but the contents of its internal registers are retained. The DMA controller (DMAC), DRAM interface, and on-chip supporting modules do not halt in sleep mode. Modules which have been placed in standby by the module standby function, however, remain halted.

20.3.2 Exit from Sleep Mode

Sleep mode is exited by an interrupt, or by input at the $\overline{\text{RES}}$ or $\overline{\text{STBY}}$ pin.

Exit by Interrupt: An interrupt terminates sleep mode and causes a transition to the interrupt exception handling state. Sleep mode is not exited by an interrupt source in an on-chip supporting module if the interrupt is disabled in the on-chip supporting module. Sleep mode is not exited by an interrupt other than NMI if the interrupt is masked by interrupt priority settings and the settings of the I and UI bits in CCR, IPR.

Exit by $\overline{\text{RES}}$ Input: Low input at the $\overline{\text{RES}}$ pin exits from sleep mode to the reset state.

Exit by $\overline{\text{STBY}}$ Input: Low input at the $\overline{\text{STBY}}$ pin exits from sleep mode to hardware standby mode.

20.4 Software Standby Mode

20.4.1 Transition to Software Standby Mode

To enter software standby mode, execute the SLEEP instruction while the SSBY bit is set to 1 in SYSCR.

In software standby mode, current dissipation is reduced to an extremely low level because the CPU, clock, and on-chip supporting modules all halt. The DMAC and on-chip supporting modules are reset and halted. As long as the specified voltage is supplied, however, CPU register contents and on-chip RAM data are retained. The settings of the I/O ports and DRAM interface* are also held. When the WDT is used as a watchdog timer (WT/$\overline{IT}$ = 1), the TME bit must be cleared to 0 before setting SSBY. Also, when setting TME to 1, SSBY should be cleared to 0.

Clear the BRLE bit in BRCR (inhibiting bus release) before making a transition to software standby mode.

Note: * RTCNT and bits 7 and 6 of RTMCSR are initialized. Other bits and registers hold their previous states.

20.4.2 Exit from Software Standby Mode

Software standby mode can be exited by input of an external interrupt at the NMI, $\overline{IRQ_0}$, $\overline{IRQ_1}$, or $\overline{IRQ_2}$ pin, or by input at the $\overline{RES}$ or $\overline{STBY}$ pin.

Exit by Interrupt: When an NMI, IRQ_0, IRQ_1, or IRQ_2 interrupt request signal is received, the clock oscillator begins operating. After the oscillator settling time selected by bits STS2 to STS0 in SYSCR, stable clock signals are supplied to the entire chip, software standby mode ends, and interrupt exception handling begins. Software standby mode is not exited if the interrupt enable bits of interrupts IRQ_0, IRQ_1, and IRQ_2 are cleared to 0, or if these interrupts are masked in the CPU.

Exit by $\overline{RES}$ Input: When the $\overline{RES}$ input goes low, the clock oscillator starts and clock pulses are supplied immediately to the entire chip. The $\overline{RES}$ signal must be held low long enough for the clock oscillator to stabilize. When $\overline{RES}$ goes high, the CPU starts reset exception handling.

Exit by $\overline{STBY}$ Input: Low input at the $\overline{STBY}$ pin causes a transition to hardware standby mode.

20.4.3 Selection of Waiting Time for Exit from Software Standby Mode

Bits STS2 to STS0 in SYSCR and bits DIV1 and DIV0 in DIVCR should be set as follows.

Crystal Resonator: Set STS2 to STS0, DIV1, and DIV0 so that the waiting time (for the clock to stabilize) is at least 7 ms. Table 20.3 indicates the waiting times that are selected by STS2 to STS0, DIV1, and DIV0 settings at various system clock frequencies.

External Clock: Set STS2 to STS0, DIV1, and DIV0 so that the waiting time is at least 100 µs.

Table 20.3 Clock Frequency and Waiting Time for Clock to Settle

DIV1	DIV0	STS2	STS1	STS0	Waiting Time	25 MHz	20 MHz	18 MHz	16 MHz	12 MHz	10 MHz	Unit
0	0	0	0	0	8192 states	0.3	0.4	0.46	0.51	0.65	0.8	ms
		0	0	1	16384 states	0.7	0.8	0.91	1.0	1.3	1.6	
		0	1	0	32768 states	1.3	1.6	1.8	2.0	2.7	3.3	
		0	1	1	65536 states	2.6	3.3	3.6	4.1	5.5	6.6	
		1	0	0	131072 states	5.2	6.6	7.3*	8.2*	10.9*	13.1*	
		1	0	1	262144 states	10.5*	13.1*	14.6	16.4	21.8	26.2	
		1	1	0	1024 states	0.04	0.05	0.057	0.064	0.085	0.10	
		1	1	1					Illegal setting			
0	1	0	0	0	8192 states	0.7	0.8	0.91	1.02	1.4	1.6	ms
		0	0	1	16384 states	1.3	1.6	1.8	2.0	2.7	3.3	
		0	1	0	32768 states	2.6	3.3	3.6	4.1	5.5	6.6	
		0	1	1	65536 states	5.2	6.6	7.3*	8.2*	10.9*	13.1*	
		1	0	0	131072 states	10.5*	13.1*	14.6	16.4	21.8	26.2	
		1	0	1	262144 states	21.0	26.2	29.1	32.8	43.7	52.4	
		1	1	0	1024 states	0.08	0.10	0.11	0.13	0.17	0.20	
		1	1	1					Illegal setting			
1	0	0	0	0	8192 states	1.3	1.6	1.8	2.0	2.7	3.3	ms
		0	0	1	16384 states	2.6	3.3	3.6	4.1	5.5	6.6	
		0	1	0	32768 states	5.2	6.6	7.3*	8.2*	10.9*	13.1*	
		0	1	1	65536 states	10.5*	13.1*	14.6	16.4	21.8	26.2	
		1	0	0	131072 states	21.0	26.2	29.1	32.8	43.7	52.4	
		1	0	1	262144 states	41.9	52.4	58.3	65.5	87.4	104.9	
		1	1	0	1024 states	0.16	0.20	0.23	0.26	0.34	0.41	
		1	1	1					Illegal setting			
1	1	0	0	0	8192 states	2.6	3.3	3.6	4.1	5.5	6.6	ms
		0	0	1	16384 states	5.2	6.6	7.3*	8.2*	10.9*	13.1*	
		0	1	0	32768 states	10.5	13.1*	14.6	16.4	21.8	26.2	
		0	1	1	65536 states	21.0*	26.2	29.1	32.8	43.7	52.4	
		1	0	0	131072 states	41.9	52.4	58.3	65.5	87.4	104.9	
		1	0	1	262144 states	83.9	104.9	116.5	131.1	174.8	209.7	
		1	1	0	1024 states	0.33	0.41	0.46	0.51	0.68	0.82	
		1	1	1					Illegal setting			

* : Recommended setting

20.4.4 Sample Application of Software Standby Mode

Figure 20.1 shows an example in which software standby mode is entered at the fall of NMI and exited at the rise of NMI.

With the NMI edge select bit (NMIEG) cleared to 0 in SYSCR (selecting the falling edge), an NMI interrupt occurs. Next the NMIEG bit is set to 1 (selecting the rising edge) and the SSBY bit is set to 1; then the SLEEP instruction is executed to enter software standby mode.

Software standby mode is exited at the next rising edge of the NMI signal.

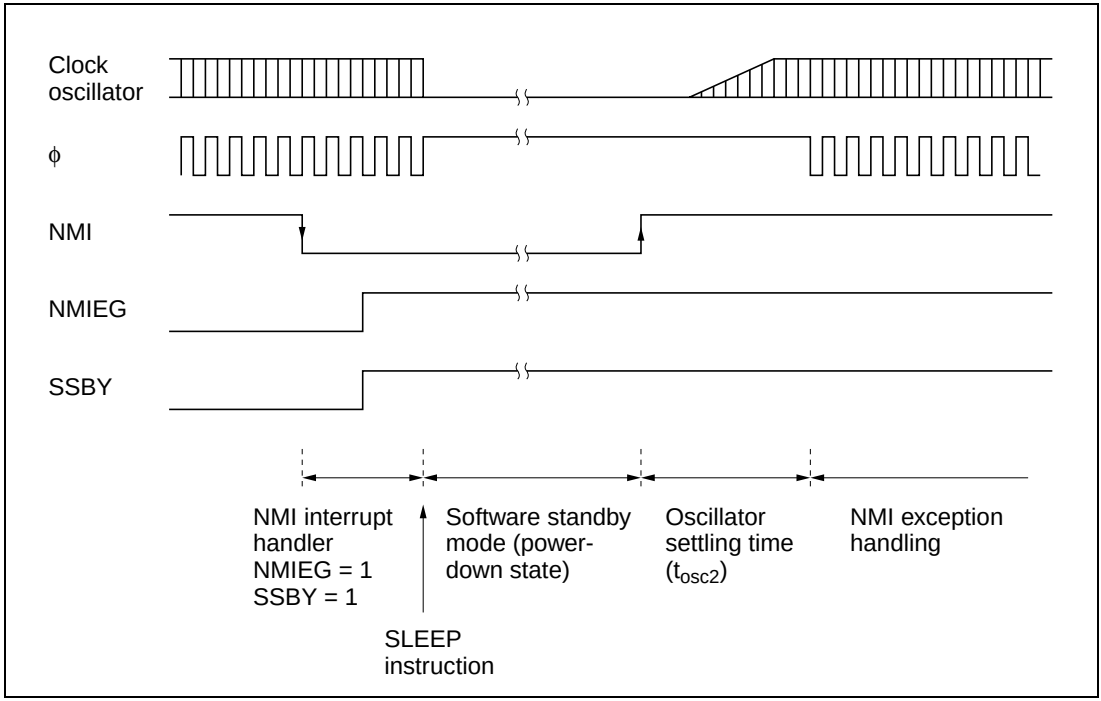


Figure 20.1 NMI Timing for Software Standby Mode (Example)

20.4.5 Note

The I/O ports retain their existing states in software standby mode. If a port is in the high output state, its output current is not reduced.

20.5 Hardware Standby Mode

20.5.1 Transition to Hardware Standby Mode

Regardless of its current state, the chip enters hardware standby mode whenever the $\overline{\text{STBY}}$ pin goes low. Hardware standby mode reduces power consumption drastically by halting all functions of the CPU, DMAC, DRAM interface, and on-chip supporting modules. All modules are reset except the on-chip RAM. As long as the specified voltage is supplied, on-chip RAM data is retained. I/O ports are placed in the high-impedance state.

Clear the RAME bit to 0 in SYSCR before $\overline{\text{STBY}}$ goes low to retain on-chip RAM data.

The inputs at the mode pins (MD2 to MD0) should not be changed during hardware standby mode.

Note : Do not select the hardware standby mode during the reset period following power-on.

20.5.2 Exit from Hardware Standby Mode

Hardware standby mode is exited by inputs at the $\overline{\text{STBY}}$ and $\overline{\text{RES}}$ pins. While $\overline{\text{RES}}$ is low, when $\overline{\text{STBY}}$ goes high, the clock oscillator starts running. $\overline{\text{RES}}$ should be held low long enough for the clock oscillator to settle. When $\overline{\text{RES}}$ goes high, reset exception handling begins, followed by a transition to the program execution state.

20.5.3 Timing for Hardware Standby Mode

Figure 20.2 shows the timing relationships for hardware standby mode. To enter hardware standby mode, first drive $\overline{\text{RES}}$ low, then drive $\overline{\text{STBY}}$ low. To exit hardware standby mode, first drive $\overline{\text{STBY}}$ high, wait for the clock to settle, then bring $\overline{\text{RES}}$ from low to high.

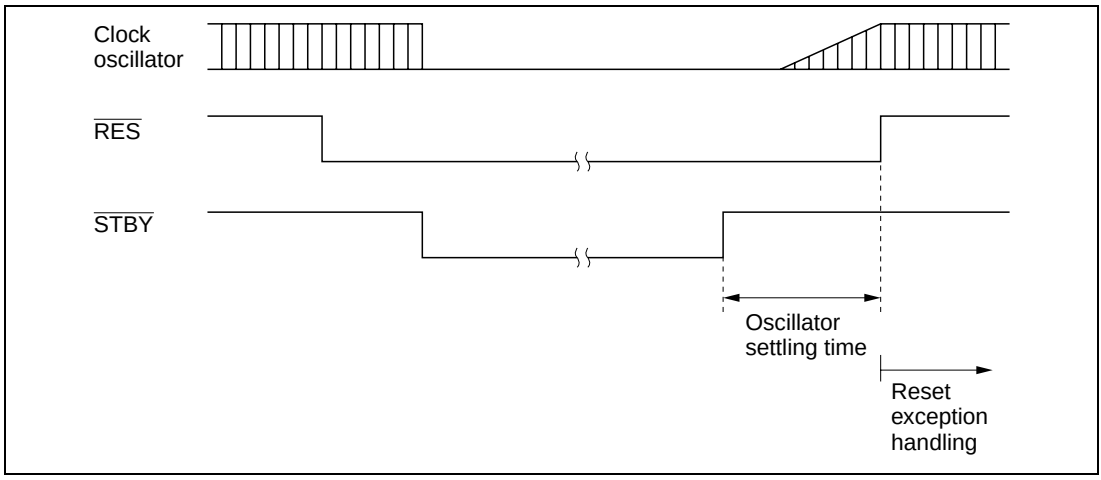


Figure 20.2 Hardware Standby Mode Timing

20.5.4 Timing for Hardware Standby Mode at Power-On

Figure 20.3 shows the timing relationships for entering hardware standby mode when the power is turned on.

To make a transition to hardware standby mode when the power is turned on, hold the $\overline{\text{RES}}$ pin low for the stipulated time while keeping the $\overline{\text{STBY}}$ pin high. After the reset is cleared, set the $\overline{\text{STBY}}$ pin low.

For details on exiting hardware standby mode, see section 20.5.3, Timing for Hardware Standby Mode.

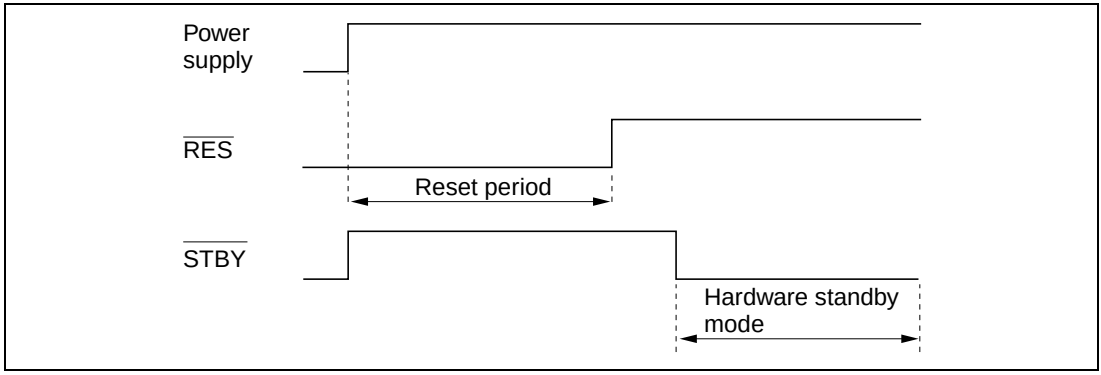


Figure 20.3 Timing for Hardware Standby Mode at Power-On

20.6 Module Standby Function

20.6.1 Module Standby Timing

The module standby function can halt several of the on-chip supporting modules (SCI2, SCI1, SCI0, the DMAC, 16-bit timer, 8-bit timer, DRAM interface, and A/D converter) independently in the power-down state. This standby function is controlled by bits MSTPH2 to MSTPH0 in MSTCRH and bits MSTPL7 to MSTPL0 in MSTCRL. When one of these bits is set to 1, the corresponding on-chip supporting module is placed in standby and halts at the beginning of the next bus cycle after the MSTCR write cycle.

20.6.2 Read/Write in Module Standby

When an on-chip supporting module is in module standby, read/write access to its registers is disabled. Read access always results in H'FF data. Write access is ignored.

20.6.3 Usage Notes

When using the module standby function, note the following points.

DMAC: When setting a bit in MSTCR to 1 to place the DMAC in module standby, make sure that the DMAC is not currently requesting the bus right. If the corresponding bit in MSTCR is set to 1 when a bus request is present, operation of the bus arbiter becomes ambiguous and a malfunction may occur.

DRAM Interface: When the module standby function is used on the DRAM interface, set the MSTCR bit to 1 while DRAM space is deselected.

On-Chip Supporting Module Interrupts: Before setting a module standby bit, first disable interrupts by that module. When an on-chip supporting module is placed in standby by the module standby function, its registers are initialized, including registers with interrupt request flags.

Pin States: Pins used by an on-chip supporting module lose their module functions when the module is placed in module standby. What happens after that depends on the particular pin. For details, see section 8, I/O Ports. Pins that change from the input to the output state require special care. For example, if SCI1 is placed in module standby, the receive data pin loses its receive data function and becomes a port pin. If its port DDR bit is set to 1, the pin becomes a data output pin, and its output may collide with external SCI transmit data. Data collision should be prevented by clearing the port DDR bit to 0 or taking other appropriate action.

Register Resetting: When an on-chip supporting module is halted by the module standby function, all its registers are initialized. To restart the module, after its MSTCR bit is cleared to 0, its registers must be set up again. It is not possible to write to the registers while the MSTCR bit is set to 1.

MSTCR Access from DMAC Disabled: To prevent malfunctions, MSTCR can only be accessed from the CPU. It can be read by the DMAC, but it cannot be written by the DMAC.

20.7 System Clock Output Disabling Function

Output of the system clock (ϕ) can be controlled by the PSTOP bit in MSTCRH. When the PSTOP bit is set to 1, output of the system clock halts and the ϕ pin is placed in the high-impedance state. Figure 20.4 shows the timing of the stopping and starting of system clock output. When the PSTOP bit is cleared to 0, output of the system clock is enabled. Table 20.4 indicates the state of the ϕ pin in various operating states.

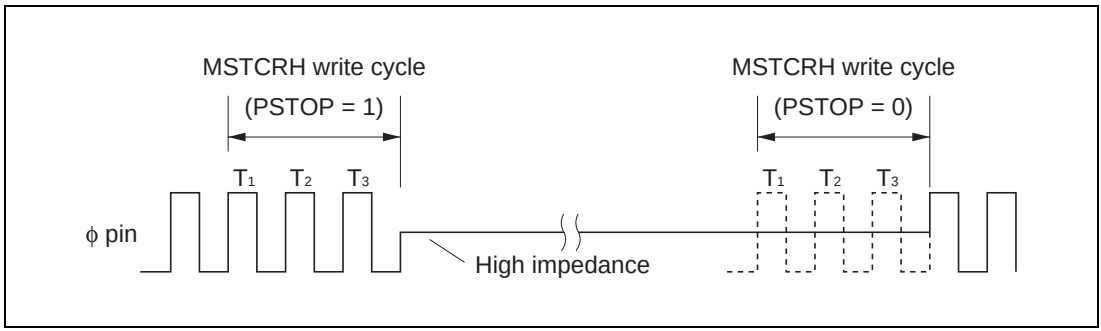


Figure 20.4 Starting and Stopping of System Clock Output

Table 20.4 ϕ Pin State in Various Operating States

Operating State	PSTOP = 0	PSTOP = 1
Hardware standby	High impedance	High impedance
Software standby	Always high	High impedance
Sleep mode	System clock output	High impedance
Normal operation	System clock output	High impedance

21.1 Electrical Characteristics of HD64F3069RF25 and HD64F3069RTE25

21.1.1 Absolute Maximum Ratings

Table 21.1 lists the absolute maximum ratings.

Table 21.1 Absolute Maximum Ratings

Item	Symbol	Value	Unit
Power supply voltage	V_{CC}*[1]	–0.3 to +7.0	V
Input voltage (FWE)*[2]	V_{in}	–0.3 to V_{CC} +0.3	V
Input voltage (except for port 7)*[2]	V_{in}	–0.3 to V_{CC} +0.3	V
Input voltage (port 7)	V_{in}	–0.3 to AV_{CC} +0.3	V
Reference voltage	V_{REF}	–0.3 to AV_{CC} +0.3	V
Analog power supply voltage	AV_{CC}	–0.3 to +7.0	V
Analog input voltage	V_{AN}	–0.3 to AV_{CC} +0.3	V
Operating temperature	T_{opr}	Regular specifications: –20 to +75*[3]	°C
Storage temperature	T_{stg}	–55 to +125	°C

Caution: Permanent damage to the chip may result if absolute maximum ratings are exceeded.

Notes: 1. Do not apply the power supply voltage to the V_{CL} pin. Connect an external capacitor between this pin and GND.

2. 12 V must not be applied to any pin, as this may cause permanent damage to the device.

3. The operating temperature range for flash memory programming/erasing is T_a = 0 to +75°C (Regular specifications).

21.1.2 DC Characteristics

Table 21.2 lists the DC characteristics. Table 21.3 lists the permissible output currents.

Table 21.2 DC Characteristics

Conditions: V_{CC} = AV_{CC} = 5.0 V ± 10%, V_{REF} = 4.5 V to AV_{CC}*[1], V_{SS} = AV_{SS} = 0 V*[1],
T_a =–20°C to +75°C (Regular specifications),
[Programming/erasing conditions: T_a = 0°C to +75°C (Regular specifications)]

Item		Symbol	Min	Typ	Max	Unit	Test Conditions
Schmitt trigger input voltages	Port A, $P8_0$ to $P8_2$	V_T^-	1.0	—	—	V	
		V_T^+	—	—	$V_{CC} \times 0.7$	V	
		$V_T^+ - V_T^-$	0.4	—	—	V	
Input high voltage	$\overline{STBY}$, $\overline{RES}$, NMI, MD_2 to MD_0, FWE	V_{IH}	V_{CC} – 0.7	—	V_{CC} + 0.3	V	
	EXTAL		$V_{CC} \times 0.7$	—	V_{CC} + 0.3	V	
	Port 7		2.0	—	AV_{CC} + 0.3	V	
	Ports 1 to 6, $P8_3$, $P8_4$, $P9_0$ to $P9_5$, port B		2.0	—	V_{CC} + 0.3	V	
Input low voltage	$\overline{STBY}$, $\overline{RES}$, FWE, MD_2 to MD_0	V_{IL}	–0.3	—	0.5	V	
	NMI, EXTAL, ports 1 to 7, $P8_3$, $P8_4$, $P9_0$ to $P9_5$, port B		–0.3	—	0.8	V	
Output high voltage	All output pins	V_{OH}	V_{CC} – 0.5	—	—	V	I_{OH} = –200 µA
			3.5	—	—	V	I_{OH} = –1 mA
Output low voltage	All output pins	V_{OL}	—	—	0.4	V	I_{OL} = 1.6 mA
	Ports 1, 2, and 5		—	—	1.0	V	I_{OL} = 10 mA
Input leakage current	$\overline{STBY}$, $\overline{RES}$, NMI, FWE, MD_2 to MD_0	$\|I_{in}\|$	—	—	1.0	µA	V_{in} = 0.5 V to V_{CC} – 0.5 V
	Port 7		—	—	1.0	µA	V_{in} = 0.5 V to AV_{CC} – 0.5 V

Item		Symbol	Min	Typ	Max	Unit	Test Conditions
Three-state leakage current	Ports 1 to 6, Ports 8 to B	$\|I_{TSI}\|$	—	—	1.0	µA	V_{in} = 0.5 V to V_{CC} – 0.5 V
Input pull-up MOS current	Ports 2, 4, and 5	$-I_p$	50	—	360	µA	V_{in} = 0 V
Input capacitance	FWE	C_{in}	—	—	80	pF	V_{in} = 0 V, f = f_{min}, T_a = 25°C
	NMI		—	—	50	pF	
	All input pins except NMI		—	—	15	pF	
Current dissipation*[2]	Normal operation	I_{CC}*[3]	—	24 (5.0 V)	36	mA	f = 25 MHz
	Sleep mode		—	20 (5.0 V)	33	mA	f = 25 MHz
	Module standby mode		—	15 (5.0 V)	25	mA	f = 25 MHz
	Standby mode		—	25 (5.0 V)	90	µA	$T_a \leq$ 50°C
			—	—	120	µA	50°C < T_a
	Flash memory programming/ erasing*[4]		—	34 (5.0 V)	46	mA	f = 25 MHz
Analog power supply current	During A/D conversion	AI_{CC}	—	0.9	1.5	mA	
	During A/D and D/A conversion		—	0.9	1.5	mA	
	Idle		—	0.05 (5.0 V)	5	µA	$T_a \leq$ 50°C at DASTE = 0
			—	—	15	µA	50°C < T_a at DASTE = 0

Item		Symbol	Min	Typ	Max	Unit	Test Conditions
Reference current	During A/D conversion	AI_{CC}	—	0.45	0.8	mA	
	During A/D and D/A conversion		—	1.8	3.0	mA	
	Idle		—	0.05	5.0	µA	DASTE = 0
RAM standby voltage		V_{RAM}	3.0	—	—	V	
V_{CL} output voltage*[5]	Normal operation	V_{CL}	1.5	1.9	2.3	V	V_{CC} = 5.0V T_a = 25°C
V_{CC} start voltage*[6]		$V_{CC\ START}$	—	0	0.8	V	
V_{CC} rise rate*[6]		SV_{CC}	0.05	—	—	V/ms	

Notes:
1. If the A/D converter is not used, do not leave the AV_{CC}, V_{REF}, and AV_{SS} pins open. Connect AV_{CC} and V_{REF} to V_{CC}, and connect AV_{SS} to V_{SS}.
2. Current dissipation values are for V_{IH} min = V_{CC} – 0.5 V and V_{IL} max = 0.5 V with all output pins unloaded and the on-chip MOS pull-up transistors in the off state.
3. I_{CC} max. (normal operation) = 15 (mA) + 0.15 (mA/(MHz × V)) × V_{CC} × f
   I_{CC} max. (sleep mode) = 15 (mA) + 0.13 (mA/(MHz × V)) × V_{CC} × f
   I_{CC} max. (sleep mode + module standby mode)
   = 15 (mA) + 0.07 (mA/(MHz × V)) × V_{CC} × f
   The Typ values for power consumption are reference values.
4. Sum of current dissipation in normal operation and current dissipation in program/erase operations.
5. This value is applied when the external capacitor of 0.1 µF is connected. This characteristic does not specify the permissible range of voltage input from the external circuit but specifies the voltage output by the LSI.
6. These characteristics are applied under the condition in which the $\overline{RES}$ pin goes low when powering on.

Table 21.3 Permissible Output Currents

Conditions: $V_{CC} = AV_{CC} = 5.0\ V \pm 10\%$, $V_{REF} = 4.5\ V$ to AV_{CC}, $V_{SS} = AV_{SS} = 0\ V$,
$T_a = -20°C$ to $+75°C$ (Regular specifications)

Item		Symbol	Min	Typ	Max	Unit
Permissible output low current (per pin)	Ports 1, 2, and 5	I_{OL}	—	—	10	mA
	Other output pins		—	—	2.0	mA
Permissible output low current (total)	Total of 20 pins in Ports 1, 2, and 5	ΣI_{OL}	—	—	80	mA
	Total of all output pins, including the above		—	—	120	mA
Permissible output high current (per pin)	All output pins	$\lvert -I_{OH} \rvert$	—	—	2.0	mA
Permissible output high current (total)	Total of all output pins	$\lvert -\Sigma I_{OH} \rvert$	—	—	40	mA

Notes: 1. To protect chip reliability, do not exceed the output current values in table 21.3.
2. When directly driving a darlington pair or LED, always insert a current-limiting resistor in the output line, as shown in figures 21.1 and 21.2.

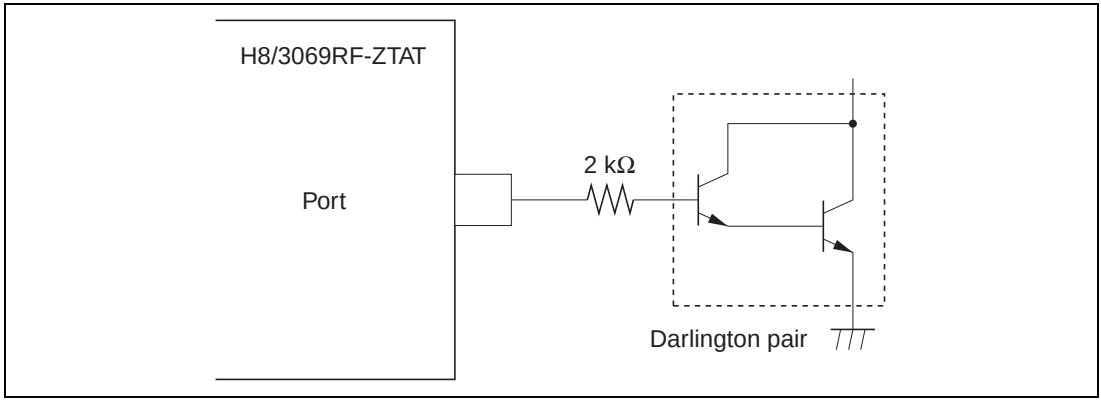


Figure 21.1 Darlington Pair Drive Circuit (Example)

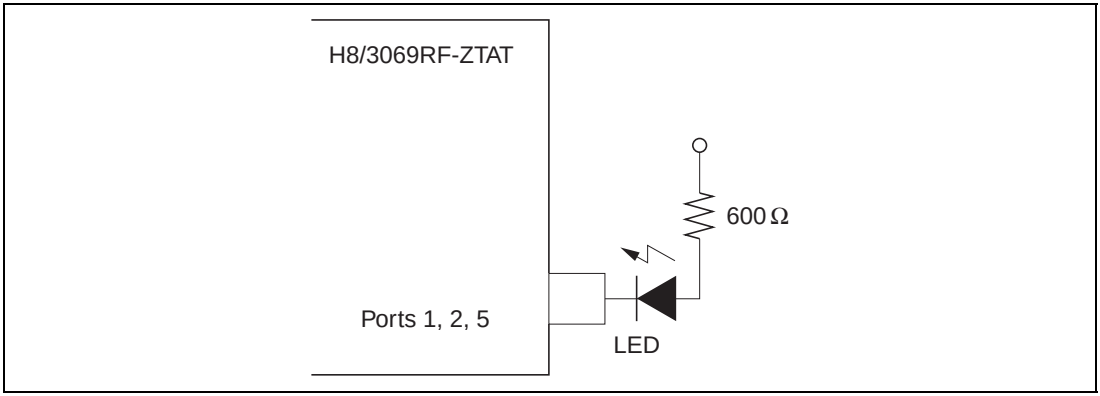


Figure 21.2 Sample LED Circuit

21.1.3 AC Characteristics

Clock timing parameters are listed in table 21.4, control signal timing parameters in table 21.5, and bus timing parameters in table 21.6. Timing parameters of the on-chip supporting modules are listed in table 21.7.

Table 21.4 Clock Timing

Condition: T_a = –20°C to +75°C (Regular specifications),
$V_{CC} = AV_{CC}$ = 5.0 V ± 10%, V_{REF} = 4.5 V to AV_{CC}, $V_{SS} = AV_{SS}$ = 0 V, fmax = 25 MHz

Item	Symbol	Min	Max	Unit	Test Conditions
Clock cycle time	t_{cyc}	40	100	ns	Figure 21.13
Clock pulse low width	t_{CL}	10	—	ns	
Clock pulse high width	t_{CH}	10	—	ns	
Clock rise time	t_{Cr}	—	10	ns	
Clock fall time	t_{Cf}	—	10	ns	
Clock oscillator settling time at reset	t_{OSC1}	20	—	ms	Figure 21.10
Clock oscillator settling time in software standby	t_{OSC2}	7	—	ms	Figure 20.1

Table 21.5 Control Signal Timing

Conditions: T_a = –20°C to +75°C (Regular specifications),
$V_{CC} = AV_{CC}$ = 5.0 V ± 10%, V_{REF} = 4.5 V to AV_{CC}, $V_{SS} = AV_{SS}$ = 0 V, fmax = 25 MHz

Item	Symbol	Min	Max	Unit	Test Conditions
$\overline{RES}$ setup time	t_{RESS}	150	—	ns	Figure 21.11
$\overline{RES}$ pulse width	t_{RESW}	20	—	t_{cyc}	
Mode programming setup time	t_{MDS}	200	—	ns	
NMI, $\overline{IRQ}$ setup time	t_{NMIS}	150	—	ns	Figure 21.12
NMI, $\overline{IRQ}$ hold time	t_{NMIH}	10	—	ns	
NMI, $\overline{IRQ}$ pulse width	t_{NMIW}	200	—	ns	

Table 21.6 Bus Timing

Conditions: T_a = –20°C to +75°C (Regular specifications),
V_{CC} = AV_{CC} = 5.0 V ± 10%, V_{REF} = 4.5 V to AV_{CC}, V_{SS} = AV_{SS} = 0 V, fmax = 25 MHz

Item	Symbol	Min	Max	Unit	Test Conditions
Address delay time	t_{AD}	—	25	ns	Figure 21.13, Figure 21.14, Figure 21.16, Figure 21.17, Figure 21.19
Address hold time	t_{AH}	0.5 t_{cyc} – 20	—	ns	
Read strobe delay time	t_{RSD}	—	25	ns	
Address strobe delay time	t_{ASD}	—	25	ns	
Write strobe delay time	t_{WSD}	—	25	ns	
Strobe delay time	t_{SD}	—	25	ns	
Write strobe pulse width 1	t_{WSW1}	1.0 t_{cyc} – 25	—	ns	
Write strobe pulse width 2	t_{WSW2}	1.5 t_{cyc} – 25	—	ns	
Address setup time 1	t_{AS1}	0.5 t_{cyc} – 20	—	ns	
Address setup time 2	t_{AS2}	1.0 t_{cyc} – 20	—	ns	
Read data setup time	t_{RDS}	25	—	ns	
Read data hold time	t_{RDH}	0	—	ns	
Write data delay time	t_{WDD}	—	35	ns	
Write data setup time 1	t_{WDS1}	1.0 t_{cyc} – 30	—	ns	
Write data setup time 2	t_{WDS2}	2.0 t_{cyc} – 30	—	ns	
Write data hold time	t_{WDH}	0.5 t_{cyc} – 15	—	ns	

Item	Symbol	Min	Max	Unit	Test Conditions
Read data access time 1	t_{ACC1}	—	2.0 t_{cyc} – 45	ns	Figure 21.13, Figure 21.14, Figure 21.16, Figure 21.17
Read data access time 2	t_{ACC2}	—	3.0 t_{cyc} – 45	ns	
Read data access time 3	t_{ACC3}	—	1.5 t_{cyc} – 45	ns	
Read data access time 4	t_{ACC4}	—	2.5 t_{cyc} – 45	ns	
Precharge time 1	t_{PCH1}	1.0 t_{cyc} – 20	—	ns	
Precharge time 2	t_{PCH2}	0.5 t_{cyc} – 20	—	ns	
Wait setup time	t_{WTS}	25	—	ns	Figure 21.15
Wait hold time	t_{WTH}	5	—	ns	
Bus request setup time	t_{BRQS}	25	—	ns	Figure 21.18
Bus acknowledge delay time 1	t_{BACD1}	—	30	ns	
Bus acknowledge delay time 2	t_{BACD2}	—	30	ns	
Bus-floating time	t_{BZD}	—	30	ns	
$\overline{RAS}$ precharge time	t_{RP}	1.5 t_{cyc} – 25	—	ns	Figure 21.19, Figure 21.20
$\overline{CAS}$ precharge time	t_{CP}	0.5 t_{cyc} – 15	—	ns	
Low address hold time	t_{RAH}	0.5 t_{cyc} – 15	—	ns	
$\overline{RAS}$ delay time 1	t_{RAD1}	—	25	ns	
$\overline{RAS}$ delay time 2	t_{RAD2}	—	30	ns	
$\overline{CAS}$ delay time 1	t_{CASD1}	—	25	ns	
$\overline{CAS}$ delay time 2	t_{CASD2}	—	25	ns	
$\overline{WE}$ delay time	t_{WCD}	—	25	ns	

Item	Symbol	Min	Max	Unit	Test Conditions
$\overline{CAS}$ pulse width 1	t_{CAS1}	1.5 t_{cyc} – 20	—	ns	Figure 21.19 to Figure 21.21
$\overline{CAS}$ pulse width 2	t_{CAS2}	1.0 t_{cyc} – 20	—	ns	
$\overline{CAS}$ pulse width 3	t_{CAS3}	1.0 t_{cyc} – 20	—	ns	
$\overline{RAS}$ access time	t_{RAC}	—	2.5 t_{cyc} – 40	ns	
Address access time	t_{AA}	—	2.0 t_{cyc} – 50	ns	
$\overline{CAS}$ access time	t_{CAC}	—	1.5 t_{cyc} – 50	ns	
$\overline{WE}$ setup time	t_{WCS}	0.5 t_{cyc} – 20	—	ns	
$\overline{WE}$ hold time	t_{WCH}	0.5 t_{cyc} – 15	—	ns	
Write data setup time	t_{WDS}	0.5 t_{cyc} – 20	—	ns	
$\overline{WE}$ write data hold time	t_{WDH}	0.5 t_{cyc} – 15	—	ns	
$\overline{CAS}$ setup time 1	t_{CSR1}	0.5 t_{cyc} – 20	—	ns	
$\overline{CAS}$ setup time 2	t_{CSR2}	0.5 t_{cyc} – 15	—	ns	
$\overline{CAS}$ hold time	t_{CHR}	0.5 t_{cyc} – 15	—	ns	
$\overline{RAS}$ pulse width	t_{RAS}	1.5 t_{cyc} – 15	—	ns	

Note: In order to secure the address hold time relative to the rise of the $\overline{RD}$ strobe, address update mode 2 should be used. For details see section 6.3.5, Address Output Method.

Table 21.7 Timing of On-Chip Supporting Modules

Conditions: T_a = –20°C to +75°C (Regular specifications),
V_{CC} = AV_{CC} = 5.0 V ± 10%, V_{REF} = 4.5 V to AV_{CC}, V_{SS} = AV_{SS} = 0 V, fmax = 25 MHz

Module	Item		Symbol	Min	Max	Unit	Test Conditions
Ports and TPC	Output data delay time		t_{PWD}	—	50	ns	Figure 21.22
	Input data setup time		t_{PRS}	50	—	ns	
	Input data hold time		t_{PRH}	50	—	ns	
16-bit timer	Timer output delay time		t_{TOCD}	—	50	ns	Figure 21.23
	Timer input setup time		t_{TICS}	50	—	ns	
	Timer clock input setup time		t_{TCKS}	50	—	ns	Figure 21.24
	Timer clock pulse width	Single edge	t_{TCKWH}	1.5	—	t_{cyc}	
		Both edges	t_{TCKWL}	2.5	—	t_{cyc}	
8-bit timer	Timer output delay time		t_{TOCD}	—	50	ns	Figure 21.23
	Timer input setup time		t_{TICS}	50	—	ns	
	Timer clock input setup time		t_{TCKS}	50	—	ns	Figure 21.24
	Timer clock pulse width	Single edge	t_{TCKWH}	1.5	—	t_{cyc}	
		Both edges	t_{TCKWL}	2.5	—	t_{cyc}	

Module	Item		Symbol	Min	Max	Unit	Test Conditions
SCI	Input clock cycle	Asynchronous	t_{Scyc}	4	—	t_{cyc}	Figure 21.25
		Synchronous		6	—	t_{cyc}	
	Input clock rise time		t_{SCKr}	—	1.5	t_{cyc}	
	Input clock fall time		t_{SCKf}	—	1.5	t_{cyc}	
	Input clock pulse width		t_{SCKW}	0.4	0.6	t_{Scyc}	
	Transmit data delay time		t_{TXD}	—	100	ns	Figure 21.26
	Receive data setup time (synchronous)		t_{RXS}	100	—	ns	
	Receive data hold time (synchronous)	Clock input	t_{RXH}	100	—	ns	
		Clock output		0	—	ns	
DMAC	$\overline{\text{TEND}}$ delay time 1		t_{TED1}	—	50	ns	Figure 21.27, Figure 21.28
	$\overline{\text{TEND}}$ delay time 2		t_{TED2}	—	50	ns	
	$\overline{\text{DREQ}}$ setup time		t_{DRQS}	25	—	ns	Figure 21.29
	$\overline{\text{DREQ}}$ hold time		t_{DRQH}	10	—	ns	

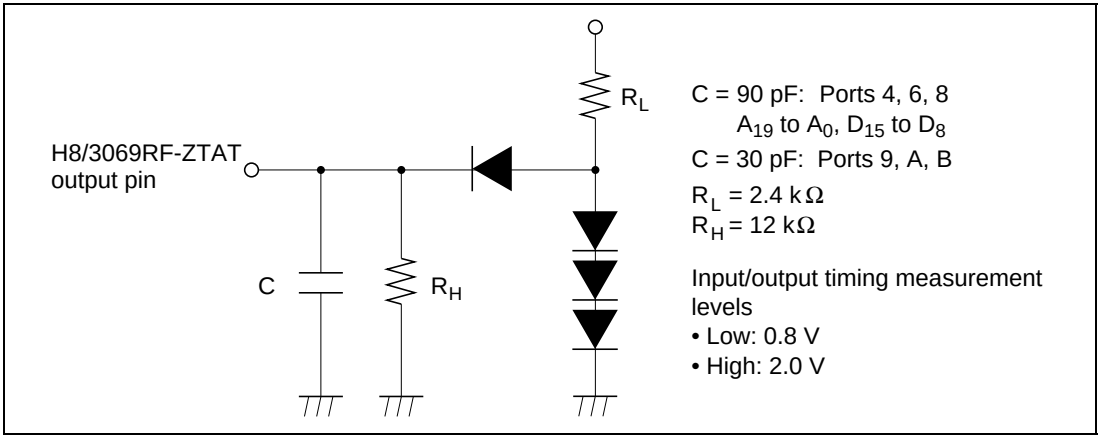


Figure 21.3 Output Load Circuit

21.1.4 A/D Conversion Characteristics

Table 21.8 lists the A/D conversion characteristics.

Table 21.8 A/D Conversion Characteristics

Conditions: T_a = –20°C to +75°C (Regular specifications),
$V_{CC} = AV_{CC}$ = 5.0 V ± 10%, V_{REF} = 4.5 V to AV_{CC}, $V_{SS} = AV_{SS}$ = 0 V, fmax = 25 MHz

Item			Min	Typ	Max	Unit
Conversion time: 134 states	Resolution		10	10	10	bits
	Conversion time (single mode)		—	—	134	t_{cyc}
	Analog input capacitance		—	—	20	pF
	Permissible signal-source impedance	$\phi \leq$ 13 MHz	—	—	10	kΩ
		$\phi >$ 13 MHz	—	—	5	kΩ
	Nonlinearity error		—	—	±3.5	LSB
	Offset error		—	—	±3.5	LSB
	Full-scale error		—	—	±3.5	LSB
	Quantization error		—	—	±0.5	LSB
	Absolute accuracy		—	—	±4.0	LSB

Item			Min	Typ	Max	Unit
Conversion time: 70 states	Resolution		10	10	10	bits
	Conversion time (single mode)		—	—	70	t_{cyc}
	Analog input capacitance		—	—	20	pF
	Permissible signal-source impedance	$\phi \leq$ 13 MHz	—	—	5	kΩ
		$\phi >$ 13 MHz	—	—	3	kΩ
	Nonlinearity error		—	—	±7.5	LSB
	Offset error		—	—	±7.5	LSB
	Full-scale error		—	—	±7.5	LSB
	Quantization error		—	—	±0.5	LSB
	Absolute accuracy		—	—	±8.0	LSB

21.1.5 D/A Conversion Characteristics

Table 21.9 lists the D/A conversion characteristics.

Table 21.9 D/A Conversion Characteristics

Conditions: T_a = –20°C to +75°C (Regular specifications),
V_{CC} = AV_{CC} = 5.0 V ± 10%, V_{REF} = 4.5 V to AV_{CC}, V_{SS} = AV_{SS} = 0 V, fmax = 25 MHz

Item	Min	Typ	Max	Unit	Test Conditions
Resolution	8	8	8	bits	
Conversion time (centering time)	—	—	10	µs	20 pF capacitive load
Absolute accuracy	—	±1.5	±2.0	LSB	2 MΩ resistive load
	—	—	±1.5	LSB	4 MΩ resistive load

21.1.6 Flash Memory Characteristics

Table 21.10 shows the flash memory characteristics.

Table 21.10 Flash Memory Characteristics

Conditions: V_{CC} = AV_{CC} = 4.5 V to 5.5 V, V_{SS} = AV_{SS} = 0 V,
T_a = 0°C to +75°C (operating temperature range for programming/erasing : Regular specifications)

Item	Symbol	Min	Typ	Max	Unit	Notes
Programming time*1 *2 *4	t_P	—	3	30	ms/ 128 bytes	
Erase time*1 *2 *4	t_E	—	80	800	ms/4k blocks	
		—	500	5000	ms/32k blocks	
		—	1000	10000	ms/64k blocks	
Programming time (total)*1 *2 *4	Σt_P	—	10	30	s/512k bytes	T_a = 25°C, all "0"
Erase time (total)*1 *2 *4	Σt_E	—	10	30	s/512k bytes	T_a = 25°C
Programming and erase time (total)*1 *2 *4	Σt_{PE}	—	20	60	s/512k bytes	T_a = 25°C
Reprogramming count	N_{WEC}	100*3	—	—	times	
Data retention time*4	t_{DRP}	10	—	—	year	

Notes: 1. Programming and erase time depend on the data size.
2. Programming and erase time excluded the data transfer time.
3. It is the number of times of min. which guarantees all the characteristics after reprogramming. (A guarantee is the range of a 1-min. value.)
4. It is the characteristic when reprogramming is performed by specification within the limits including a min. value.

21.2 Electrical Characteristics of HD64F3069RF25W and HD64F3069RTE25W

21.2.1 Absolute Maximum Ratings

Table 21.11 lists the absolute maximum ratings.

Table 21.11 Absolute Maximum Ratings

Item	Symbol	Value	Unit
Power supply voltage	V_{CC}*[1]	–0.3 to +7.0	V
Input voltage (FWE)*[2]	V_{in}	–0.3 to V_{CC} +0.3	V
Input voltage (except for port 7)*[2]	V_{in}	–0.3 to V_{CC} +0.3	V
Input voltage (port 7)	V_{in}	–0.3 to AV_{CC} +0.3	V
Reference voltage	V_{REF}	–0.3 to AV_{CC} +0.3	V
Analog power supply voltage	AV_{CC}	–0.3 to +7.0	V
Analog input voltage	V_{AN}	–0.3 to AV_{CC} +0.3	V
Operating temperature	T_{opr}	Wide-range specifications: –40 to +85*[3]	°C
Storage temperature	T_{stg}	–55 to +125	°C

Caution: Permanent damage to the chip may result if absolute maximum ratings are exceeded.

Notes: 1. Do not apply the power supply voltage to the V_{CL} pin. Connect an external capacitor between this pin and GND.

2. 12 V must not be applied to any pin, as this may cause permanent damage to the device.

3. The operating temperature range for flash memory programming/erasing is T_a = 0 to +85°C (Wide-range specifications).

21.2.2 DC Characteristics

Table 21.12 lists the DC characteristics. Table 21.13 lists the permissible output currents.

Table 21.12 DC Characteristics

Conditions: $V_{CC} = AV_{CC} = 5.0\ V \pm 10\%$, $V_{REF} = 4.5\ V$ to AV_{CC}*[1], $V_{SS} = AV_{SS} = 0\ V$*[1],
$T_a = -40°C$ to $+85°C$ (Wide-range specifications),
[Programming/erasing conditions: $T_a = 0°C$ to $+85°C$ (Wide-range specifications)]

Item		Symbol	Min	Typ	Max	Unit	Test Conditions
Schmitt trigger input voltages	Port A, $P8_0$ to $P8_2$	V_T^-	1.0	—	—	V	
		V_T^+	—	—	$V_{CC} \times 0.7$	V	
		$V_T^+ - V_T^-$	0.4	—	—	V	
Input high voltage	$\overline{STBY}$, $\overline{RES}$, NMI, MD_2 to MD_0, FWE	V_{IH}	$V_{CC} - 0.7$	—	$V_{CC} + 0.3$	V	
	EXTAL		$V_{CC} \times 0.7$	—	$V_{CC} + 0.3$	V	
	Port 7		2.0	—	$AV_{CC} + 0.3$	V	
	Ports 1 to 6, $P8_3$, $P8_4$, $P9_0$ to $P9_5$, port B		2.0	—	$V_{CC} + 0.3$	V	
Input low voltage	$\overline{STBY}$, $\overline{RES}$, FWE, MD_2 to MD_0	V_{IL}	–0.3	—	0.5	V	
	NMI, EXTAL, ports 1 to 7, $P8_3$, $P8_4$, $P9_0$ to $P9_5$, port B		–0.3	—	0.8	V	
Output high voltage	All output pins	V_{OH}	$V_{CC} - 0.5$	—	—	V	$I_{OH} = -200\ \mu A$
			3.5	—	—	V	$I_{OH} = -1\ mA$
Output low voltage	All output pins	V_{OL}	—	—	0.4	V	$I_{OL} = 1.6\ mA$
	Ports 1, 2, and 5		—	—	1.0	V	$I_{OL} = 10\ mA$
Input leakage current	$\overline{STBY}$, $\overline{RES}$, NMI, FWE, MD_2 to MD_0	$\lvert I_{in} \rvert$	—	—	1.0	µA	$V_{in} = 0.5\ V$ to $V_{CC} - 0.5\ V$
	Port 7		—	—	1.0	µA	$V_{in} = 0.5\ V$ to $AV_{CC} - 0.5\ V$

Item		Symbol	Min	Typ	Max	Unit	Test Conditions
Three-state leakage current	Ports 1 to 6, Ports 8 to B	$\|I_{TSI}\|$	—	—	1.0	µA	V_{in} = 0.5 V to V_{CC} – 0.5 V
Input pull-up MOS current	Ports 2, 4, and 5	$-I_p$	50	—	360	µA	V_{in} = 0 V
Input capacitance	FWE	C_{in}	—	—	80	pF	V_{in} = 0 V, f = f_{min}, T_a = 25°C
	NMI		—	—	50	pF	
	All input pins except NMI		—	—	15	pF	
Current dissipation*[2]	Normal operation	I_{CC}*[3]	—	24 (5.0 V)	36	mA	f = 25 MHz
	Sleep mode		—	20 (5.0 V)	33	mA	f = 25 MHz
	Module standby mode		—	15 (5.0 V)	25	mA	f = 25 MHz
	Standby mode		—	25 (5.0 V)	90	µA	$T_a \leq$ 50°C
			—	—	120	µA	50°C < T_a
	Flash memory programming/ erasing*[4]		—	34 (5.0 V)	46	mA	f = 25 MHz
Analog power supply current	During A/D conversion	AI_{CC}	—	0.9	1.5	mA	
	During A/D and D/A conversion		—	0.9	1.5	mA	
	Idle		—	0.05 (5.0 V)	5	µA	$T_a \leq$ 50°C at DASTE = 0
			—	—	15	µA	50°C < T_a at DASTE = 0

Item		Symbol	Min	Typ	Max	Unit	Test Conditions
Reference current	During A/D conversion	AI_{CC}	—	0.45	0.8	mA	
	During A/D and D/A conversion		—	1.8	3.0	mA	
	Idle		—	0.05	5.0	µA	DASTE = 0
RAM standby voltage		V_{RAM}	3.0	—	—	V	
V_{CL} output voltage*[5]	Normal operation	V_{CL}	1.5	1.9	2.3	V	V_{CC} = 5.0V T_a = 25°C
V_{CC} start voltage*[6]		$V_{CC\ START}$	—	0	0.8	V	
V_{CC} rise rate*[6]		SV_{CC}	0.05	—	—	V/ms	

Notes: 1. If the A/D converter is not used, do not leave the AV_{CC}, V_{REF}, and AV_{SS} pins open. Connect AV_{CC} and V_{REF} to V_{CC}, and connect AV_{SS} to V_{SS}.

2. Current dissipation values are for V_{IH} min = V_{CC} – 0.5 V and V_{IL} max = 0.5 V with all output pins unloaded and the on-chip MOS pull-up transistors in the off state.

3. I_{CC} max. (normal operation) = 15 (mA) + 0.15 (mA/(MHz × V)) × V_{CC} × f
   I_{CC} max. (sleep mode) = 15 (mA) + 0.13 (mA/(MHz × V)) × V_{CC} × f
   I_{CC} max. (sleep mode + module standby mode)
   = 15 (mA) + 0.07 (mA/(MHz × V)) × V_{CC} × f
   The Typ values for power consumption are reference values.

4. Sum of current dissipation in normal operation and current dissipation in program/erase operations.

5. This value is applied when the external capacitor of 0.1 µF is connected. This characteristic does not specify the permissible range of voltage input from the external circuit but specifies the voltage output by the LSI.

6. These characteristics are applied under the condition in which the $\overline{RES}$ pin goes low when powering on.

Table 21.13 Permissible Output Currents

Conditions: $V_{CC} = AV_{CC} = 5.0\ V \pm 10\%$, $V_{REF} = 4.5\ V$ to AV_{CC}, $V_{SS} = AV_{SS} = 0\ V$,
$T_a = –40°C$ to $+85°C$ (Wide-range specifications),

Item		Symbol	Min	Typ	Max	Unit
Permissible output low current (per pin)	Ports 1, 2, and 5	I_{OL}	—	—	10	mA
	Other output pins		—	—	2.0	mA
Permissible output low current (total)	Total of 20 pins in Ports 1, 2, and 5	ΣI_{OL}	—	—	80	mA
	Total of all output pins, including the above		—	—	120	mA
Permissible output high current (per pin)	All output pins	$\lvert -I_{OH} \rvert$	—	—	2.0	mA
Permissible output high current (total)	Total of all output pins	$\lvert -\Sigma I_{OH} \rvert$	—	—	40	mA

Notes: 1. To protect chip reliability, do not exceed the output current values in table 21.13.
2. When directly driving a darlington pair or LED, always insert a current-limiting resistor in the output line, as shown in figures 21.4 and 21.5.

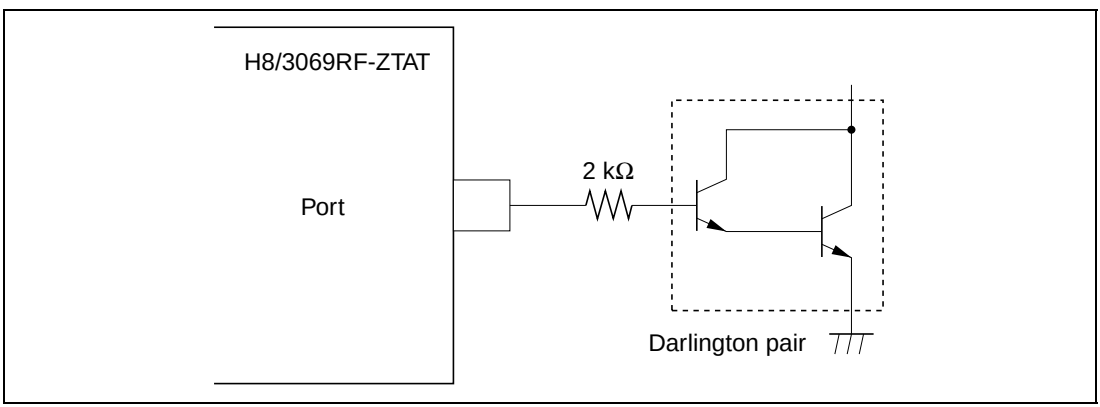


Figure 21.4 Darlington Pair Drive Circuit (Example)

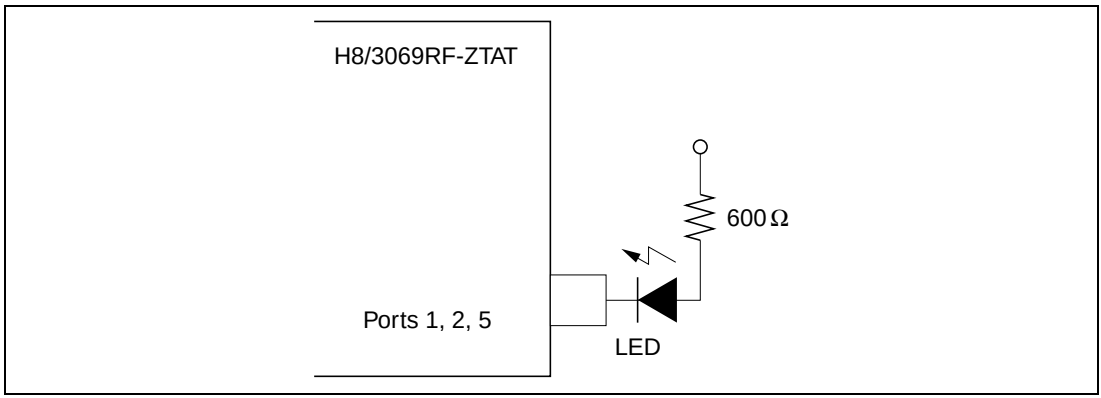


Figure 21.5 Sample LED Circuit

21.2.3 AC Characteristics

Clock timing parameters are listed in table 21.14, control signal timing parameters in table 21.15, and bus timing parameters in table 21.16. Timing parameters of the on-chip supporting modules are listed in table 21.17.

Table 21.14 Clock Timing

Condition: T_a = –40°C to +85°C (Wide-range specifications),
$V_{CC} = AV_{CC}$ = 5.0 V ± 10%, V_{REF} = 4.5 V to AV_{CC}, $V_{SS} = AV_{SS}$ = 0 V, fmax = 25 MHz

Item	Symbol	Min	Max	Unit	Test Conditions
Clock cycle time	t_{cyc}	40	100	ns	Figure 21.13
Clock pulse low width	t_{CL}	10	—	ns	
Clock pulse high width	t_{CH}	10	—	ns	
Clock rise time	t_{Cr}	—	10	ns	
Clock fall time	t_{Cf}	—	10	ns	
Clock oscillator settling time at reset	t_{OSC1}	20	—	ms	Figure 21.10
Clock oscillator settling time in software standby	t_{OSC2}	7	—	ms	Figure 20.1

Table 21.15 Control Signal Timing

Conditions: T_a = –40°C to +85°C (Wide-range specifications),
$V_{CC} = AV_{CC}$ = 5.0 V ± 10%, V_{REF} = 4.5 V to AV_{CC}, $V_{SS} = AV_{SS}$ = 0 V, fmax = 25 MHz

Item	Symbol	Min	Max	Unit	Test Conditions
$\overline{RES}$ setup time	t_{RESS}	150	—	ns	Figure 21.11
$\overline{RES}$ pulse width	t_{RESW}	20	—	t_{cyc}	
Mode programming setup time	t_{MDS}	200	—	ns	
NMI, $\overline{IRQ}$ setup time	t_{NMIS}	150	—	ns	Figure 21.12
NMI, $\overline{IRQ}$ hold time	t_{NMIH}	10	—	ns	
NMI, $\overline{IRQ}$ pulse width	t_{NMIW}	200	—	ns	

Table 21.16 Bus Timing

Conditions: T_a = –40°C to +85°C (Wide-range specifications),
V_{CC} = AV_{CC} = 5.0 V ± 10%, V_{REF} = 4.5 V to AV_{CC}, V_{SS} = AV_{SS} = 0 V, fmax = 25 MHz

Item	Symbol	Min	Max	Unit	Test Conditions
Address delay time	t_{AD}	—	25	ns	Figure 21.13, Figure 21.14, Figure 21.16, Figure 21.17, Figure 21.19
Address hold time	t_{AH}	0.5 t_{cyc} – 20	—	ns	
Read strobe delay time	t_{RSD}	—	25	ns	
Address strobe delay time	t_{ASD}	—	25	ns	
Write strobe delay time	t_{WSD}	—	25	ns	
Strobe delay time	t_{SD}	—	25	ns	
Write strobe pulse width 1	t_{WSW1}	1.0 t_{cyc} – 25	—	ns	
Write strobe pulse width 2	t_{WSW2}	1.5 t_{cyc} – 25	—	ns	
Address setup time 1	t_{AS1}	0.5 t_{cyc} – 20	—	ns	
Address setup time 2	t_{AS2}	1.0 t_{cyc} – 20	—	ns	
Read data setup time	t_{RDS}	25	—	ns	
Read data hold time	t_{RDH}	0	—	ns	
Write data delay time	t_{WDD}	—	35	ns	
Write data setup time 1	t_{WDS1}	1.0 t_{cyc} – 30	—	ns	
Write data setup time 2	t_{WDS2}	2.0 t_{cyc} – 30	—	ns	
Write data hold time	t_{WDH}	0.5 t_{cyc} – 15	—	ns	

Item	Symbol	Min	Max	Unit	Test Conditions
Read data access time 1	t_{ACC1}	—	2.0 t_{cyc} – 45	ns	Figure 21.13, Figure 21.14, Figure 21.16, Figure 21.17
Read data access time 2	t_{ACC2}	—	3.0 t_{cyc} – 45	ns	
Read data access time 3	t_{ACC3}	—	1.5 t_{cyc} – 45	ns	
Read data access time 4	t_{ACC4}	—	2.5 t_{cyc} – 45	ns	
Precharge time 1	t_{PCH1}	1.0 t_{cyc} – 20	—	ns	
Precharge time 2	t_{PCH2}	0.5 t_{cyc} – 20	—	ns	
Wait setup time	t_{WTS}	25	—	ns	Figure 21.15
Wait hold time	t_{WTH}	5	—	ns	
Bus request setup time	t_{BRQS}	25	—	ns	Figure 21.18
Bus acknowledge delay time 1	t_{BACD1}	—	30	ns	
Bus acknowledge delay time 2	t_{BACD2}	—	30	ns	
Bus-floating time	t_{BZD}	—	30	ns	
$\overline{RAS}$ precharge time	t_{RP}	1.5 t_{cyc} – 25	—	ns	Figure 21.19, Figure 21.20
$\overline{CAS}$ precharge time	t_{CP}	0.5 t_{cyc} – 15	—	ns	
Low address hold time	t_{RAH}	0.5 t_{cyc} – 15	—	ns	
$\overline{RAS}$ delay time 1	t_{RAD1}	—	25	ns	
$\overline{RAS}$ delay time 2	t_{RAD2}	—	30	ns	
$\overline{CAS}$ delay time 1	t_{CASD1}	—	25	ns	
$\overline{CAS}$ delay time 2	t_{CASD2}	—	25	ns	
$\overline{WE}$ delay time	t_{WCD}	—	25	ns	

Item	Symbol	Min	Max	Unit	Test Conditions
$\overline{CAS}$ pulse width 1	t_{CAS1}	1.5 t_{cyc} – 20	—	ns	Figure 21.19 to Figure 21.21
$\overline{CAS}$ pulse width 2	t_{CAS2}	1.0 t_{cyc} – 20	—	ns	
$\overline{CAS}$ pulse width 3	t_{CAS3}	1.0 t_{cyc} – 20	—	ns	
$\overline{RAS}$ access time	t_{RAC}	—	2.5 t_{cyc} – 40	ns	
Address access time	t_{AA}	—	2.0 t_{cyc} – 50	ns	
$\overline{CAS}$ access time	t_{CAC}	—	1.5 t_{cyc} – 50	ns	
$\overline{WE}$ setup time	t_{WCS}	0.5 t_{cyc} – 20	—	ns	
$\overline{WE}$ hold time	t_{WCH}	0.5 t_{cyc} – 15	—	ns	
Write data setup time	t_{WDS}	0.5 t_{cyc} – 20	—	ns	
$\overline{WE}$ write data hold time	t_{WDH}	0.5 t_{cyc} – 15	—	ns	
$\overline{CAS}$ setup time 1	t_{CSR1}	0.5 t_{cyc} – 20	—	ns	
$\overline{CAS}$ setup time 2	t_{CSR2}	0.5 t_{cyc} – 15	—	ns	
$\overline{CAS}$ hold time	t_{CHR}	0.5 t_{cyc} – 15	—	ns	
$\overline{RAS}$ pulse width	t_{RAS}	1.5 t_{cyc} – 15	—	ns	

Note: In order to secure the address hold time relative to the rise of the $\overline{RD}$ strobe, address update mode 2 should be used. For details see section 6.3.5, Address Output Method.

Table 21.17 Timing of On-Chip Supporting Modules

Conditions: T_a = –40°C to +85°C (Wide-range specifications),
V_{CC} = AV_{CC} = 5.0 V ± 10%, V_{REF} = 4.5 V to AV_{CC}, V_{SS} = AV_{SS} = 0 V, fmax = 25 MHz

Module	Item		Symbol	Min	Max	Unit	Test Conditions
Ports and TPC	Output data delay time		t_{PWD}	—	50	ns	Figure 21.22
	Input data setup time		t_{PRS}	50	—	ns	
	Input data hold time		t_{PRH}	50	—	ns	
16-bit timer	Timer output delay time		t_{TOCD}	—	50	ns	Figure 21.23
	Timer input setup time		t_{TICS}	50	—	ns	
	Timer clock input setup time		t_{TCKS}	50	—	ns	Figure 21.24
	Timer clock pulse width	Single edge	t_{TCKWH}	1.5	—	t_{cyc}	
		Both edges	t_{TCKWL}	2.5	—	t_{cyc}	
8-bit timer	Timer output delay time		t_{TOCD}	—	50	ns	Figure 21.23
	Timer input setup time		t_{TICS}	50	—	ns	
	Timer clock input setup time		t_{TCKS}	50	—	ns	Figure 21.24
	Timer clock pulse width	Single edge	t_{TCKWH}	1.5	—	t_{cyc}	
		Both edges	t_{TCKWL}	2.5	—	t_{cyc}	

Module	Item		Symbol	Min	Max	Unit	Test Conditions
SCI	Input clock cycle	Asynchronous	t_{Scyc}	4	—	t_{cyc}	Figure 21.25
		Synchronous		6	—	t_{cyc}	
	Input clock rise time		t_{SCKr}	—	1.5	t_{cyc}	
	Input clock fall time		t_{SCKf}	—	1.5	t_{cyc}	
	Input clock pulse width		t_{SCKW}	0.4	0.6	t_{Scyc}	
	Transmit data delay time		t_{TXD}	—	100	ns	Figure 21.26
	Receive data setup time (synchronous)		t_{RXS}	100	—	ns	
	Receive data hold time (synchronous)	Clock input	t_{RXH}	100	—	ns	
		Clock output		0	—	ns	
DMAC	$\overline{\text{TEND}}$ delay time 1		t_{TED1}	—	50	ns	Figure 21.27, Figure 21.28
	$\overline{\text{TEND}}$ delay time 2		t_{TED2}	—	50	ns	
	$\overline{\text{DREQ}}$ setup time		t_{DRQS}	25	—	ns	Figure 21.29
	$\overline{\text{DREQ}}$ hold time		t_{DRQH}	10	—	ns	

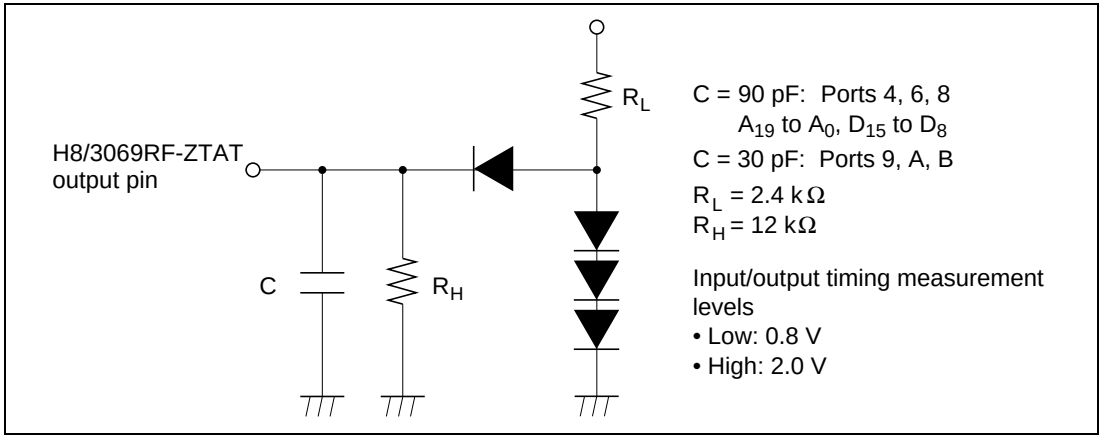


Figure 21.6 Output Load Circuit

21.2.4 A/D Conversion Characteristics

Table 21.18 lists the A/D conversion characteristics.

Table 21.18 A/D Conversion Characteristics

Conditions: T_a = –40°C to +85°C (Wide-range specifications),
$V_{CC} = AV_{CC}$ = 5.0 V ± 10%, V_{REF} = 4.5 V to AV_{CC}, $V_{SS} = AV_{SS}$ = 0 V, fmax = 25 MHz

Item			Min	Typ	Max	Unit
Conversion time: 134 states	Resolution		10	10	10	bits
	Conversion time (single mode)		—	—	134	t_{cyc}
	Analog input capacitance		—	—	20	pF
	Permissible signal-source impedance	$\phi \leq$ 13 MHz	—	—	10	kΩ
		$\phi >$ 13 MHz	—	—	5	kΩ
	Nonlinearity error		—	—	±3.5	LSB
	Offset error		—	—	±3.5	LSB
	Full-scale error		—	—	±3.5	LSB
	Quantization error		—	—	±0.5	LSB
	Absolute accuracy		—	—	±4.0	LSB

Item			Min	Typ	Max	Unit
Conversion time: 70 states	Resolution		10	10	10	bits
	Conversion time (single mode)		—	—	70	t_{cyc}
	Analog input capacitance		—	—	20	pF
	Permissible signal-source impedance	$\phi \leq$ 13 MHz	—	—	5	kΩ
		$\phi >$ 13 MHz	—	—	3	kΩ
	Nonlinearity error		—	—	±7.5	LSB
	Offset error		—	—	±7.5	LSB
	Full-scale error		—	—	±7.5	LSB
	Quantization error		—	—	±0.5	LSB
	Absolute accuracy		—	—	±8.0	LSB

21.2.5 D/A Conversion Characteristics

Table 21.19 lists the D/A conversion characteristics.

Table 21.19 D/A Conversion Characteristics

Conditions: T_a = –40°C to +85°C (Wide-range specifications),
V_{CC} = AV_{CC} = 5.0 V ± 10%, V_{REF} = 4.5 V to AV_{CC}, V_{SS} = AV_{SS} = 0 V, fmax = 25 MHz

Item	Min	Typ	Max	Unit	Test Conditions
Resolution	8	8	8	bits	
Conversion time (centering time)	—	—	10	µs	20 pF capacitive load
Absolute accuracy	—	±1.5	±2.0	LSB	2 MΩ resistive load
	—	—	±1.5	LSB	4 MΩ resistive load

21.2.6 Flash Memory Characteristics

Table 21.20 shows the flash memory characteristics.

Table 21.20 Flash Memory Characteristics

Conditions: V_{CC} = AV_{CC} = 4.5 V to 5.5 V, V_{SS} = AV_{SS} = 0 V,
T_a = 0°C to +85°C (operating temperature range for programming/erasing : Wide-range specifications)

Item	Symbol	Min	Typ	Max	Unit	Notes
Programming time*1 *2 *4	t_P	—	3	30	ms/ 128 bytes	
Erase time*1 *2 *4	t_E	—	80	800	ms/4k blocks	
		—	500	5000	ms/32k blocks	
		—	1000	10000	ms/64k blocks	
Programming time (total)*1 *2 *4	Σt_P	—	10	30	s/512k bytes	T_a = 25°C, all "0"
Erase time (total)*1 *2 *4	Σt_E	—	10	30	s/512k bytes	T_a = 25°C
Programming and erase time (total)*1 *2 *4	Σt_{PE}	—	20	60	s/512k bytes	T_a = 25°C
Reprogramming count	N_{WEC}	100*3	—	—	times	
Data retention time*4	t_{DRP}	10	—	—	year	

Notes:
1. Programming and erase time depend on the data size.
2. Programming and erase time excluded the data transfer time.
3. It is the number of times of min. which guarantees all the characteristics after reprogramming. (A guarantee is the range of a 1-min. value.)
4. It is the characteristic when reprogramming is performed by specification within the limits including a min. value.

21.3 Electrical Characteristics of HD64F3069RFBL25 and HD64F3069RTEBL25

21.3.1 Absolute Maximum Ratings

Table 21.21 lists the absolute maximum ratings.

Table 21.21 Absolute Maximum Ratings

Item	Symbol	Value	Unit
Power supply voltage	V_{CC}*[1]	–0.3 to +7.0	V
Input voltage (FWE)*[2]	V_{in}	–0.3 to V_{CC} +0.3	V
Input voltage (except for port 7)*[2]	V_{in}	–0.3 to V_{CC} +0.3	V
Input voltage (port 7)	V_{in}	–0.3 to AV_{CC} +0.3	V
Reference voltage	V_{REF}	–0.3 to AV_{CC} +0.3	V
Analog power supply voltage	AV_{CC}	–0.3 to +7.0	V
Analog input voltage	V_{AN}	–0.3 to AV_{CC} +0.3	V
Operating temperature	T_{opr}	Standard characteristics specifications: –20 to +75*[3]	°C
Storage temperature	T_{stg}	–55 to +125	°C

Caution: Permanent damage to the chip may result if absolute maximum ratings are exceeded.

Notes: 1. Do not apply the power supply voltage to the V_{CL} pin. Connect an external capacitor between this pin and GND.

2. 12 V must not be applied to any pin, as this may cause permanent damage to the device.

3. The operating temperature range for flash memory programming/erasing is T_a = 0 to +75°C (Standard characteristics specifications).

21.3.2 DC Characteristics

Table 21.22 lists the DC characteristics. Table 21.22 lists the permissible output currents.

Table 21.22 DC Characteristics

Conditions: $V_{CC} = AV_{CC} = 5.0\ V \pm 10\%$, $V_{REF} = 4.5\ V$ to AV_{CC}*[1], $V_{SS} = AV_{SS} = 0\ V$*[1],
T_a =–20°C to +75°C (Standard specifications),
[Programming/erasing conditions: T_a = 0°C to +75°C (Standard characteristics specifications)]

Item		Symbol	Min	Typ	Max	Unit	Test Conditions
Schmitt trigger input voltages	Port A, $P8_0$ to $P8_2$	V_T^-	1.0	—	—	V	
		V_T^+	—	—	$V_{CC} \times 0.7$	V	
		$V_T^+ - V_T^-$	0.4	—	—	V	
Input high voltage	$\overline{STBY}$, $\overline{RES}$, NMI, MD_2 to MD_0, FWE	V_{IH}	$V_{CC} - 0.7$	—	$V_{CC} + 0.3$	V	
	EXTAL		$V_{CC} \times 0.7$	—	$V_{CC} + 0.3$	V	
	Port 7		2.0	—	$AV_{CC} + 0.3$	V	
	Ports 1 to 6, $P8_3$, $P8_4$, $P9_0$ to $P9_5$, port B		2.0	—	$V_{CC} + 0.3$	V	
Input low voltage	$\overline{STBY}$, $\overline{RES}$, FWE, MD_2 to MD_0	V_{IL}	–0.3	—	0.5	V	
	NMI, EXTAL, ports 1 to 7, $P8_3$, $P8_4$, $P9_0$ to $P9_5$, port B		–0.3	—	0.8	V	
Output high voltage	All output pins	V_{OH}	$V_{CC} - 0.5$	—	—	V	I_{OH} = –200 µA
			3.5	—	—	V	I_{OH} = –1 mA
Output low voltage	All output pins	V_{OL}	—	—	0.4	V	I_{OL} = 1.6 mA
	Ports 1, 2, and 5		—	—	1.0	V	I_{OL} = 10 mA
Input leakage current	$\overline{STBY}$, $\overline{RES}$, NMI, FWE, MD_2 to MD_0	$\|I_{in}\|$	—	—	1.0	µA	V_{in} = 0.5 V to V_{CC} – 0.5 V
	Port 7		—	—	1.0	µA	V_{in} = 0.5 V to AV_{CC} – 0.5 V

Item		Symbol	Min	Typ	Max	Unit	Test Conditions
Three-state leakage current	Ports 1 to 6, Ports 8 to B	$\|I_{TSI}\|$	—	—	1.0	µA	V_{in} = 0.5 V to V_{CC} – 0.5 V
Input pull-up MOS current	Ports 2, 4, and 5	$-I_p$	50	—	360	µA	V_{in} = 0 V
Input capacitance	FWE	C_{in}	—	—	80	pF	V_{in} = 0 V, f = f_{min}, T_a = 25°C
	NMI		—	—	50	pF	
	All input pins except NMI		—	—	15	pF	
Current dissipation*[2]	Normal operation	I_{CC}*[3]	—	24 (5.0 V)	36	mA	f = 25 MHz
	Sleep mode		—	20 (5.0 V)	33	mA	f = 25 MHz
	Module standby mode		—	15 (5.0 V)	25	mA	f = 25 MHz
	Flash memory programming/ erasing*[4]		—	34 (5.0 V)	46	mA	f = 25 MHz
Analog power supply current	During A/D conversion	AI_{CC}	—	0.9	1.5	mA	
	During A/D and D/A conversion		—	0.9	1.5	mA	

Item		Symbol	Min	Typ	Max	Unit	Test Conditions
Reference current	During A/D conversion	AI_{CC}	—	0.45	0.8	mA	
	During A/D and D/A conversion		—	1.8	3.0	mA	
RAM standby voltage		V_{RAM}	3.0	—	—	V	
V_{CL} output voltage*[5]	Normal operation	V_{CL}	1.5	1.9	2.3	V	V_{CC} = 5.0V T_a = 25°C

Notes: 1. If the A/D converter is not used, do not leave the AV_{CC}, V_{REF}, and AV_{SS} pins open. Connect AV_{CC} and V_{REF} to V_{CC}, and connect AV_{SS} to V_{SS}.

2. Current dissipation values are for V_{IH} min = V_{CC} – 0.5 V and V_{IL} max = 0.5 V with all output pins unloaded and the on-chip MOS pull-up transistors in the off state.

3. I_{CC} max. (normal operation) = 15 (mA) + 0.15 (mA/(MHz × V)) × V_{CC} × f

   I_{CC} max. (sleep mode) = 15 (mA) + 0.13 (mA/(MHz × V)) × V_{CC} × f

   I_{CC} max. (sleep mode + module standby mode)

   = 15 (mA) + 0.07 (mA/(MHz × V)) × V_{CC} × f

   The Typ values for power consumption are reference values.

4. Sum of current dissipation in normal operation and current dissipation in program/erase operations.

5. This value is applied when the external capacitor of 0.1 µF is connected.
   This characteristic does not specify the permissible range of voltage input from the external circuit but specifies the voltage output by the LSI.

Table 21.23 Permissible Output Currents

Conditions: $V_{CC} = AV_{CC} = 5.0\ V \pm 10\%$, $V_{REF} = 4.5\ V$ to AV_{CC}, $V_{SS} = AV_{SS} = 0\ V$,
$T_a = –20°C$ to $+75°C$ (Standard characteristics specifications)

Item		Symbol	Min	Typ	Max	Unit
Permissible output low current (per pin)	Ports 1, 2, and 5	I_{OL}	—	—	10	mA
	Other output pins		—	—	2.0	mA
Permissible output low current (total)	Total of 20 pins in Ports 1, 2, and 5	ΣI_{OL}	—	—	80	mA
	Total of all output pins, including the above		—	—	120	mA
Permissible output high current (per pin)	All output pins	$\lvert -I_{OH} \rvert$	—	—	2.0	mA
Permissible output high current (total)	Total of all output pins	$\lvert -\Sigma I_{OH} \rvert$	—	—	40	mA

Notes: 1. To protect chip reliability, do not exceed the output current values in table 21.23.
2. When directly driving a darlington pair or LED, always insert a current-limiting resistor in the output line, as shown in figures 21.7 and 21.8.

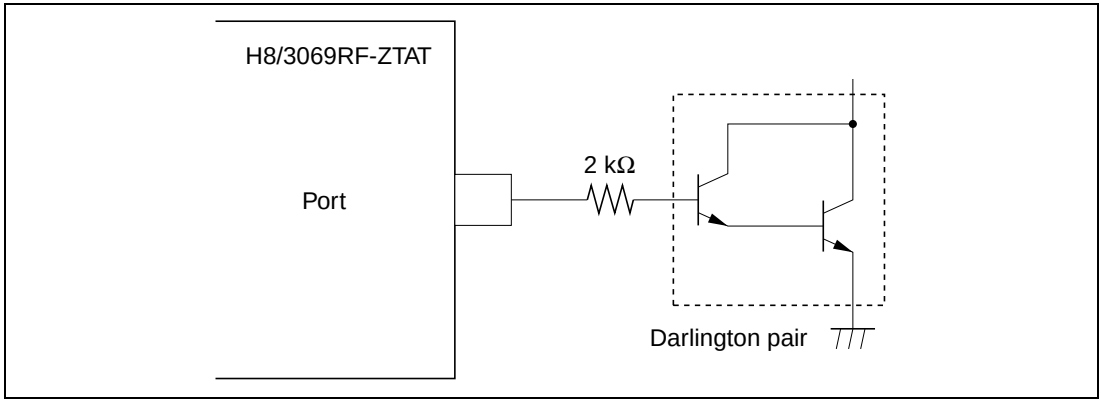


Figure 21.7 Darlington Pair Drive Circuit (Example)

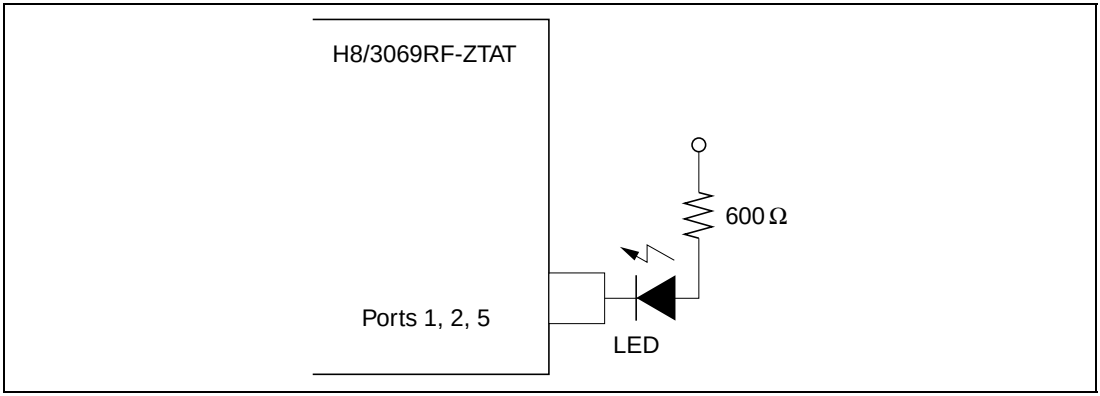


Figure 21.8 Sample LED Circuit

21.3.3 AC Characteristics

Clock timing parameters are listed in table 21.24, control signal timing parameters in table 21.25, and bus timing parameters in table 21.26. Timing parameters of the on-chip supporting modules are listed in table 21.27.

Table 21.24 Clock Timing

Condition: T_a = –20°C to +75°C (Standard characteristics specifications),
$V_{CC} = AV_{CC}$ = 5.0 V ± 10%, V_{REF} = 4.5 V to AV_{CC}, $V_{SS} = AV_{SS}$ = 0 V, fmax = 25 MHz

Item	Symbol	Min	Max	Unit	Test Conditions
Clock cycle time	t_{cyc}	40	62.5	ns	Figure 21.13
Clock pulse low width	t_{CL}	10	—	ns	
Clock pulse high width	t_{CH}	10	—	ns	
Clock rise time	t_{Cr}	—	10	ns	
Clock fall time	t_{Cf}	—	10	ns	
Clock oscillator settling time at reset	t_{OSC1}	20	—	ms	Figure 21.10
Clock oscillator settling time in software standby	t_{OSC2}	7	—	ms	Figure 20.1

Table 21.25 Control Signal Timing

Conditions: T_a = –20°C to +75°C (Standard characteristics specifications),
$V_{CC} = AV_{CC}$ = 5.0 V ± 10%, V_{REF} = 4.5 V to AV_{CC}, $V_{SS} = AV_{SS}$ = 0 V, fmax = 25 MHz

Item	Symbol	Min	Max	Unit	Test Conditions
$\overline{RES}$ setup time	t_{RESS}	150	—	ns	Figure 21.11
$\overline{RES}$ pulse width	t_{RESW}	20	—	t_{cyc}	
Mode programming setup time	t_{MDS}	200	—	ns	
NMI, $\overline{IRQ}$ setup time	t_{NMIS}	150	—	ns	Figure 21.12
NMI, $\overline{IRQ}$ hold time	t_{NMIH}	10	—	ns	
NMI, $\overline{IRQ}$ pulse width	t_{NMIW}	200	—	ns	

Table 21.26 Bus Timing

Conditions: T_a = –20°C to +75°C (Standard characteristics specifications),
V_{CC} = AV_{CC} = 5.0 V ± 10%, V_{REF} = 4.5 V to AV_{CC}, V_{SS} = AV_{SS} = 0 V, fmax = 25 MHz

Item	Symbol	Min	Max	Unit	Test Conditions
Address delay time	t_{AD}	—	25	ns	Figure 21.13,
Address hold time	t_{AH}	0.5 t_{cyc} – 20	—	ns	Figure 21.14,
Read strobe delay time	t_{RSD}	—	25	ns	Figure 21.16,
Address strobe delay time	t_{ASD}	—	25	ns	Figure 21.17, Figure 21.19
Write strobe delay time	t_{WSD}	—	25	ns	
Strobe delay time	t_{SD}	—	25	ns	
Write strobe pulse width 1	t_{WSW1}	1.0 t_{cyc} – 25	—	ns	
Write strobe pulse width 2	t_{WSW2}	1.5 t_{cyc} – 25	—	ns	
Address setup time 1	t_{AS1}	0.5 t_{cyc} – 20	—	ns	
Address setup time 2	t_{AS2}	1.0 t_{cyc} – 20	—	ns	
Read data setup time	t_{RDS}	25	—	ns	
Read data hold time	t_{RDH}	0	—	ns	
Write data delay time	t_{WDD}	—	35	ns	
Write data setup time 1	t_{WDS1}	1.0 t_{cyc} – 30	—	ns	
Write data setup time 2	t_{WDS2}	2.0 t_{cyc} – 30	—	ns	
Write data hold time	t_{WDH}	0.5 t_{cyc} – 15	—	ns	

Item	Symbol	Min	Max	Unit	Test Conditions
Read data access time 1	t_{ACC1}	—	2.0 t_{cyc} – 45	ns	Figure 21.13, Figure 21.14, Figure 21.16, Figure 21.17
Read data access time 2	t_{ACC2}	—	3.0 t_{cyc} – 45	ns	
Read data access time 3	t_{ACC3}	—	1.5 t_{cyc} – 45	ns	
Read data access time 4	t_{ACC4}	—	2.5 t_{cyc} – 45	ns	
Precharge time 1	t_{PCH1}	1.0 t_{cyc} – 20	—	ns	
Precharge time 2	t_{PCH2}	0.5 t_{cyc} – 20	—	ns	
Wait setup time	t_{WTS}	25	—	ns	Figure 21.15
Wait hold time	t_{WTH}	5	—	ns	
Bus request setup time	t_{BRQS}	25	—	ns	Figure 21.18
Bus acknowledge delay time 1	t_{BACD1}	—	30	ns	
Bus acknowledge delay time 2	t_{BACD2}	—	30	ns	
Bus-floating time	t_{BZD}	—	30	ns	
$\overline{RAS}$ precharge time	t_{RP}	1.5 t_{cyc} – 25	—	ns	Figure 21.19, Figure 21.20
$\overline{CAS}$ precharge time	t_{CP}	0.5 t_{cyc} – 15	—	ns	
Low address hold time	t_{RAH}	0.5 t_{cyc} – 15	—	ns	
$\overline{RAS}$ delay time 1	t_{RAD1}	—	25	ns	
$\overline{RAS}$ delay time 2	t_{RAD2}	—	30	ns	
$\overline{CAS}$ delay time 1	t_{CASD1}	—	25	ns	
$\overline{CAS}$ delay time 2	t_{CASD2}	—	25	ns	
$\overline{WE}$ delay time	t_{WCD}	—	25	ns	

Item	Symbol	Min	Max	Unit	Test Conditions
$\overline{CAS}$ pulse width 1	t_{CAS1}	1.5 t_{cyc} – 20	—	ns	Figure 21.19 to Figure 21.21
$\overline{CAS}$ pulse width 2	t_{CAS2}	1.0 t_{cyc} – 20	—	ns	
$\overline{CAS}$ pulse width 3	t_{CAS3}	1.0 t_{cyc} – 20	—	ns	
$\overline{RAS}$ access time	t_{RAC}	—	2.5 t_{cyc} – 40	ns	
Address access time	t_{AA}	—	2.0 t_{cyc} – 50	ns	
$\overline{CAS}$ access time	t_{CAC}	—	1.5 t_{cyc} – 50	ns	
$\overline{WE}$ setup time	t_{WCS}	0.5 t_{cyc} – 20	—	ns	
$\overline{WE}$ hold time	t_{WCH}	0.5 t_{cyc} – 15	—	ns	
Write data setup time	t_{WDS}	0.5 t_{cyc} – 20	—	ns	
$\overline{WE}$ write data hold time	t_{WDH}	0.5 t_{cyc} – 15	—	ns	
$\overline{CAS}$ setup time 1	t_{CSR1}	0.5 t_{cyc} – 20	—	ns	
$\overline{CAS}$ setup time 2	t_{CSR2}	0.5 t_{cyc} – 15	—	ns	
$\overline{CAS}$ hold time	t_{CHR}	0.5 t_{cyc} – 15	—	ns	
$\overline{RAS}$ pulse width	t_{RAS}	1.5 t_{cyc} – 15	—	ns	

Note: In order to secure the address hold time relative to the rise of the $\overline{RD}$ strobe, address update mode 2 should be used. For details see section 6.3.5, Address Output Method.

Table 21.27 Timing of On-Chip Supporting Modules

Conditions: T_a = –20°C to +75°C (Standard characteristics specifications),
V_{CC} = AV_{CC} = 5.0 V ± 10%, V_{REF} = 4.5 V to AV_{CC}, V_{SS} = AV_{SS} = 0 V, fmax = 25 MHz

Module	Item		Symbol	Min	Max	Unit	Test Conditions
Ports and TPC	Output data delay time		t_{PWD}	—	50	ns	Figure 21.22
	Input data setup time		t_{PRS}	50	—	ns	
	Input data hold time		t_{PRH}	50	—	ns	
16-bit timer	Timer output delay time		t_{TOCD}	—	50	ns	Figure 21.23
	Timer input setup time		t_{TICS}	50	—	ns	
	Timer clock input setup time		t_{TCKS}	50	—	ns	Figure 21.24
	Timer clock pulse width	Single edge	t_{TCKWH}	1.5	—	t_{cyc}	
		Both edges	t_{TCKWL}	2.5	—	t_{cyc}	
8-bit timer	Timer output delay time		t_{TOCD}	—	50	ns	Figure 21.23
	Timer input setup time		t_{TICS}	50	—	ns	
	Timer clock input setup time		t_{TCKS}	50	—	ns	Figure 21.24
	Timer clock pulse width	Single edge	t_{TCKWH}	1.5	—	t_{cyc}	
		Both edges	t_{TCKWL}	2.5	—	t_{cyc}	

Module	Item		Symbol	Min	Max	Unit	Test Conditions
SCI	Input clock cycle	Asynchronous	t_{Scyc}	4	—	t_{cyc}	Figure 21.25
		Synchronous		6	—	t_{cyc}	
	Input clock rise time		t_{SCKr}	—	1.5	t_{cyc}	
	Input clock fall time		t_{SCKf}	—	1.5	t_{cyc}	
	Input clock pulse width		t_{SCKW}	0.4	0.6	t_{Scyc}	
	Transmit data delay time		t_{TXD}	—	100	ns	Figure 21.26
	Receive data setup time (synchronous)		t_{RXS}	100	—	ns	
	Receive data hold time (synchronous)	Clock input	t_{RXH}	100	—	ns	
		Clock output		0	—	ns	
DMAC	$\overline{\text{TEND}}$ delay time 1		t_{TED1}	—	50	ns	Figure 21.27, Figure 21.28
	$\overline{\text{TEND}}$ delay time 2		t_{TED2}	—	50	ns	
	$\overline{\text{DREQ}}$ setup time		t_{DRQS}	25	—	ns	Figure 21.29
	$\overline{\text{DREQ}}$ hold time		t_{DRQH}	10	—	ns	

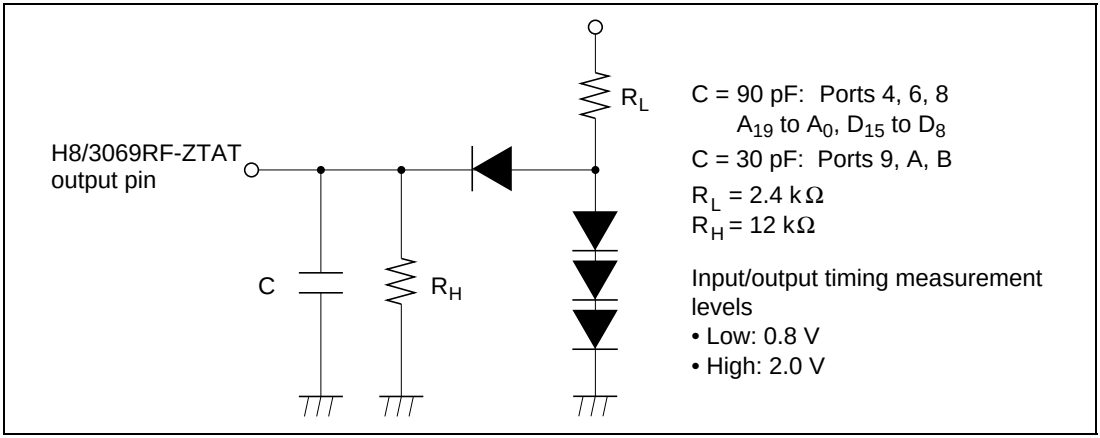


Figure 21.9 Output Load Circuit

21.3.4 A/D Conversion Characteristics

Table 21.28 lists the A/D conversion characteristics.

Table 21.28 A/D Conversion Characteristics

Conditions: T_a = –20°C to +75°C (Standard characteristics specifications),
V_{CC} = AV_{CC} = 5.0 V ± 10%, V_{REF} = 4.5 V to AV_{CC}, V_{SS} = AV_{SS} = 0 V, fmax = 25 MHz

Item			Min	Typ	Max	Unit
Conversion time: 134 states	Resolution		10	10	10	bits
	Conversion time (single mode)		—	—	134	t_{cyc}
	Analog input capacitance		—	—	20	pF
	Permissible signal-source impedance	$\phi \leq$ 13 MHz	—	—	10	kΩ
		$\phi >$ 13 MHz	—	—	5	kΩ
	Nonlinearity error		—	—	±3.5	LSB
	Offset error		—	—	±3.5	LSB
	Full-scale error		—	—	±3.5	LSB
	Quantization error		—	—	±0.5	LSB
	Absolute accuracy		—	—	±4.0	LSB

Item			Min	Typ	Max	Unit
Conversion time: 70 states	Resolution		10	10	10	bits
	Conversion time (single mode)		—	—	70	t_{cyc}
	Analog input capacitance		—	—	20	pF
	Permissible signal-source impedance	$\phi \leq$ 13 MHz	—	—	5	kΩ
		$\phi >$ 13 MHz	—	—	3	kΩ
	Nonlinearity error		—	—	±7.5	LSB
	Offset error		—	—	±7.5	LSB
	Full-scale error		—	—	±7.5	LSB
	Quantization error		—	—	±0.5	LSB
	Absolute accuracy		—	—	±8.0	LSB

21.3.5 D/A Conversion Characteristics

Table 21.29 lists the D/A conversion characteristics.

Table 21.29 D/A Conversion Characteristics

Conditions: T_a = –20°C to +75°C (Standard characteristics specifications),
V_{CC} = AV_{CC} = 5.0 V ± 10%, V_{REF} = 4.5 V to AV_{CC}, V_{SS} = AV_{SS} = 0 V, fmax = 25 MHz

Item	Min	Typ	Max	Unit	Test Conditions
Resolution	8	8	8	bits	
Conversion time (centering time)	—	—	10	µs	20 pF capacitive load
Absolute accuracy	—	±1.5	±2.0	LSB	2 MΩ resistive load
	—	—	±1.5	LSB	4 MΩ resistive load

21.3.6 Flash Memory Characteristics

Table 21.30 lists the flash memory characteristics.

Table 21.30 Flash Memory Characteristics

Conditions: V_{CC} = AV_{CC} = 4.5 V to 5.5 V, V_{SS} = AV_{SS} = 0 V,
T_a = 0°C to +75°C (operating temperature range for programming/erasing : Standard characteristics specifications)

Item	Symbol	Min	Typ	Max	Unit	Notes
Programming time*1 *2 *4	t_P	—	3	30	ms/ 128 bytes	
Erase time*1 *2 *4	t_E	—	80	800	ms/4k blocks	
		—	500	5000	ms/32k blocks	
		—	1000	10000	ms/64k blocks	
Programming time (total)*1 *2 *4	Σt_P	—	10	30	s/512k bytes	T_a = 25°C, all "0"
Erase time (total)*1 *2 *4	Σt_E	—	10	30	s/512k bytes	T_a = 25°C
Programming and erase time (total)*1 *2 *4	Σt_{PE}	—	20	60	s/512k bytes	T_a = 25°C
Reprogramming count	N_{WEC}	100*3	—	—	times	
Data retention time*4	t_{DRP}	10	—	—	year	

Notes: 1. Programming and erase time depend on the data size.
2. Programming and erase time excluded the data transfer time.
3. It is the number of times of min. which guarantees all the characteristics after reprogramming. (A guarantee is the range of a 1-min. value.)
4. It is the characteristic when reprogramming is performed by specification within the limits including a min. value.

21.4 Operational Timing

This section shows timing diagrams.

21.4.1 Clock Timing

Clock timing is shown as follows:

- Oscillator settling timing
  Figure 21.10 shows the oscillator settling timing.

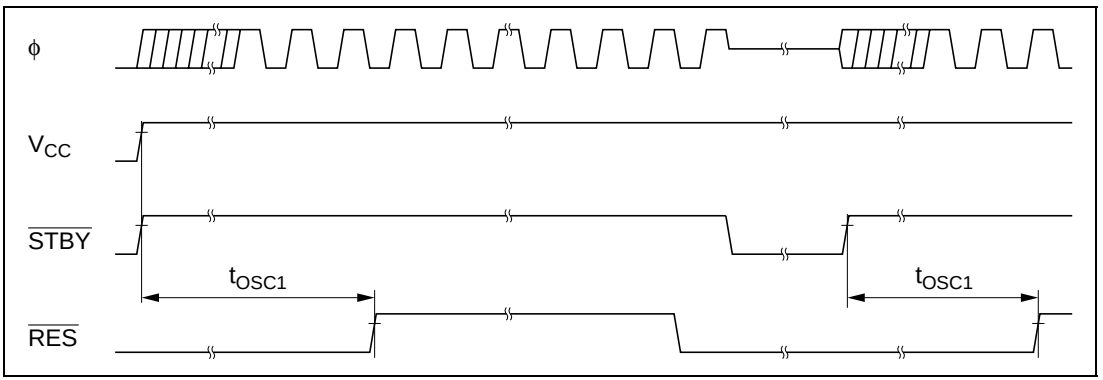


Figure 21.10 Oscillator Settling Timing

21.4.2 Control Signal Timing

Control signal timing is shown as follows:

- Reset input timing
  Figure 21.11 shows the reset input timing.
- Interrupt input timing
  Figure 21.12 shows the interrupt input timing for NMI and $\overline{IRQ_5}$ to $\overline{IRQ_0}$.

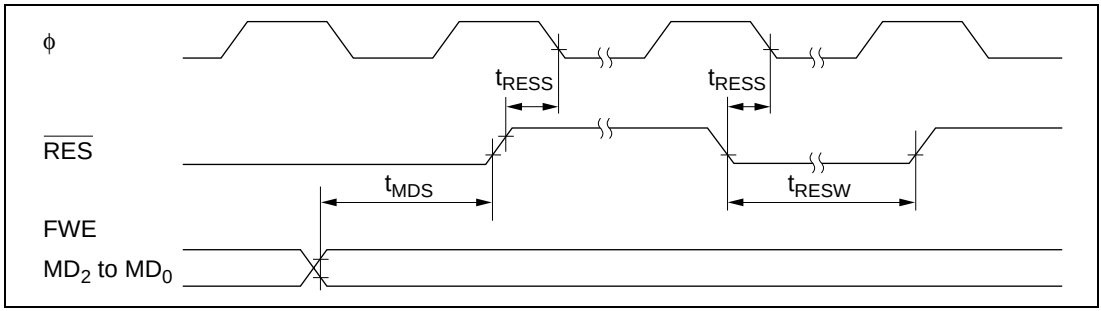


Figure 21.11 Reset Input Timing

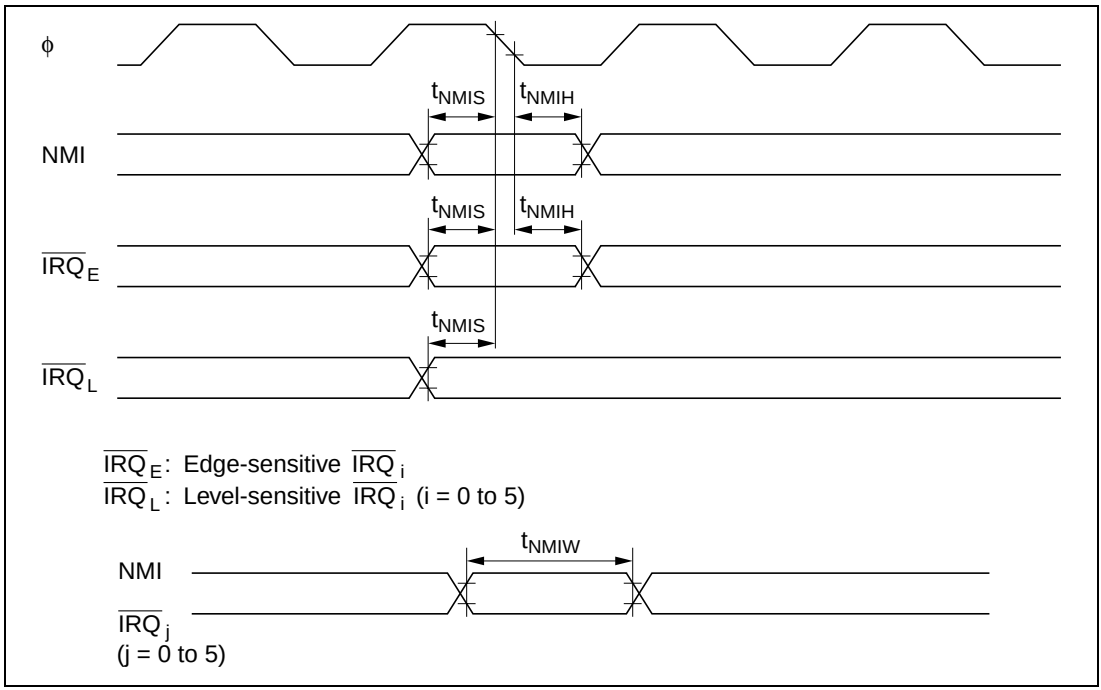


Figure 21.12 Interrupt Input Timing

21.4.3 Bus Timing

Bus timing is shown as follows:

- Basic bus cycle: two-state access

  Figure 21.13 shows the timing of the external two-state access cycle.
- Basic bus cycle: three-state access

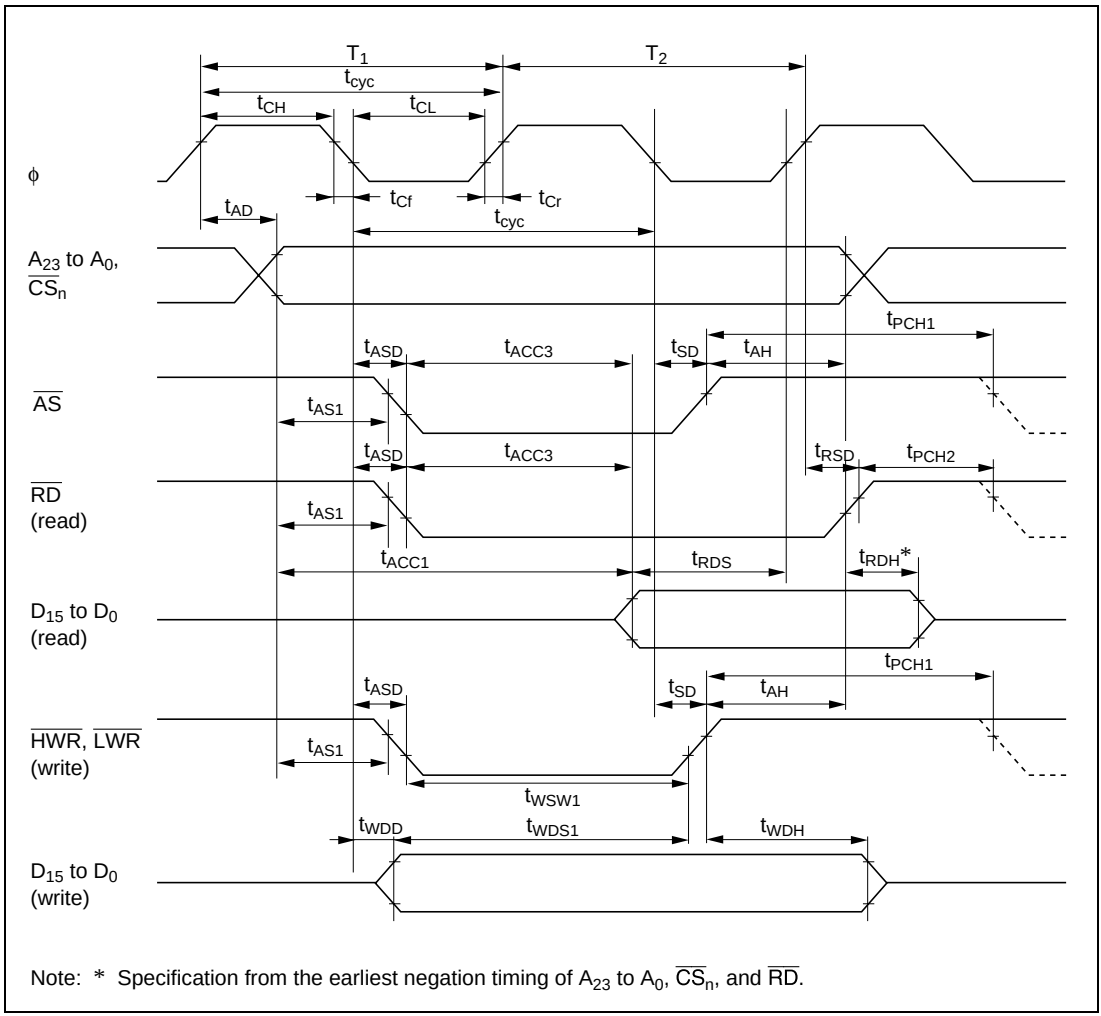
  Figure 21.14 shows the timing of the external three-state access cycle.
- Basic bus cycle: three-state access with one wait state

  Figure 21.15 shows the timing of the external three-state access cycle with one wait state inserted.

  Burst ROM access timing/burst cycle: two-state access
  Figure 21.16 shows the timing of the two-state burst cycle.

  Burst ROM access timing/burst cycle: three-state access
  Figure 21.17 shows the timing of the three-state burst cycle.

  Burst release mode timing
  Figure 21.18 shows the timing in bus release mode.



Note: * Specification from the earliest negation timing of A_{23} to A_0, $\overline{CS}_n$, and $\overline{RD}$.

Figure 21.13 Basic Bus Cycle: two State Access

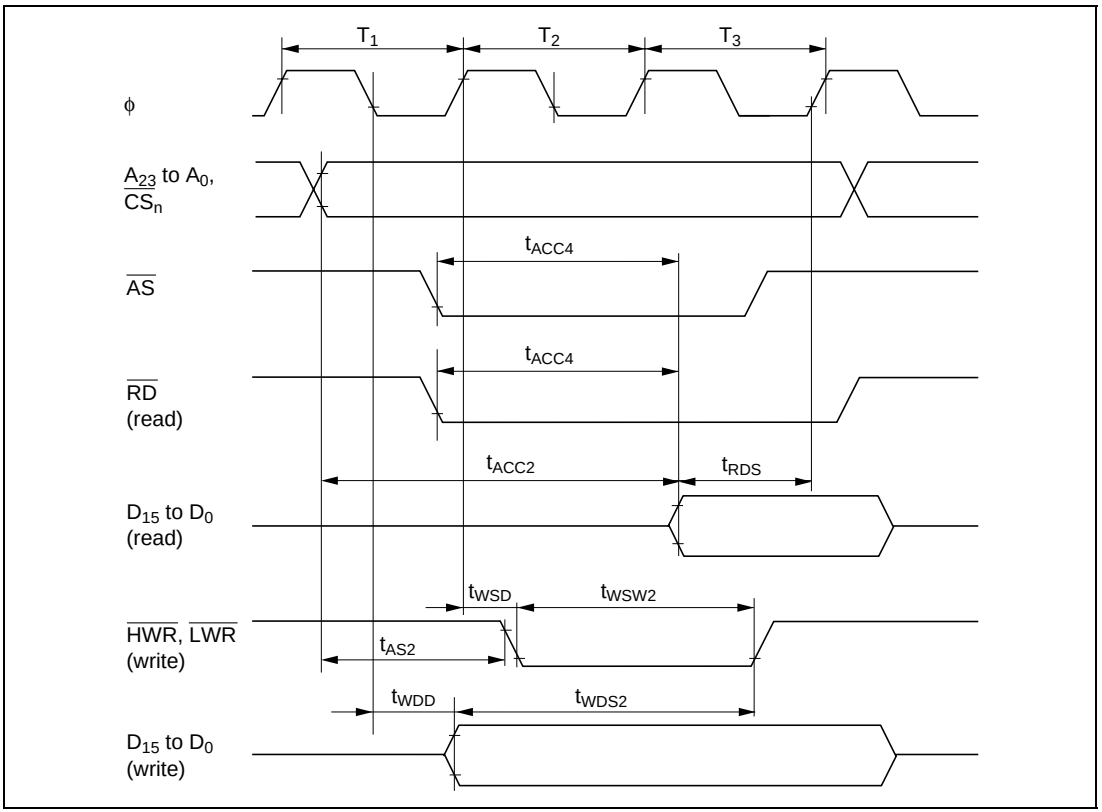


Figure 21.14 Basic Bus Cycle: three State Access

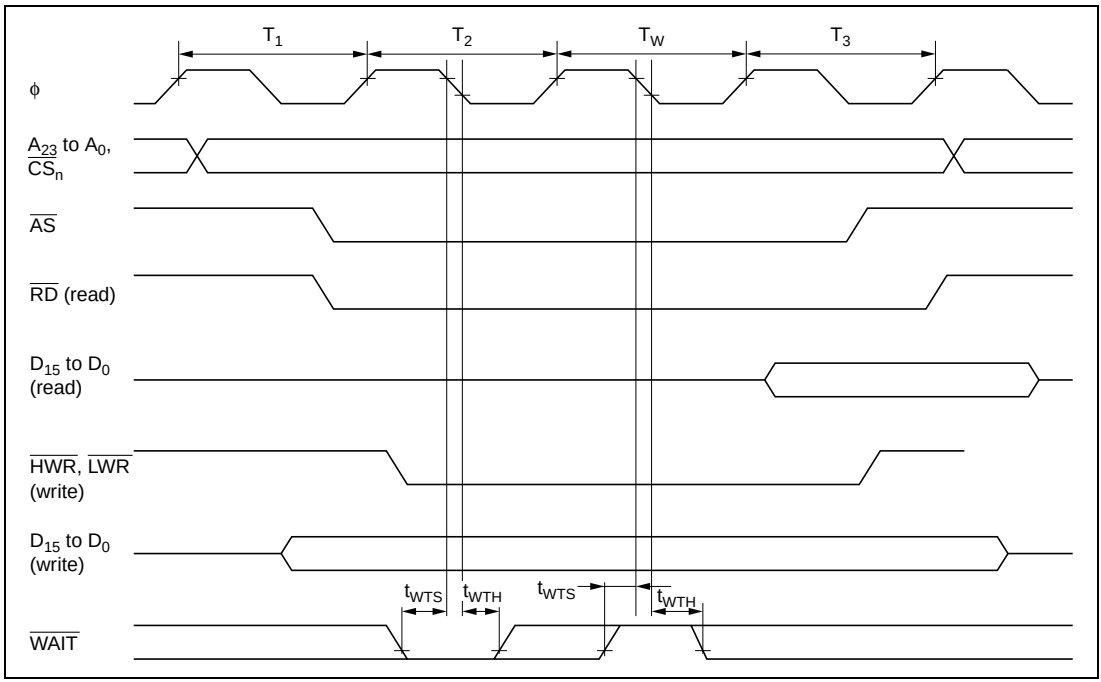
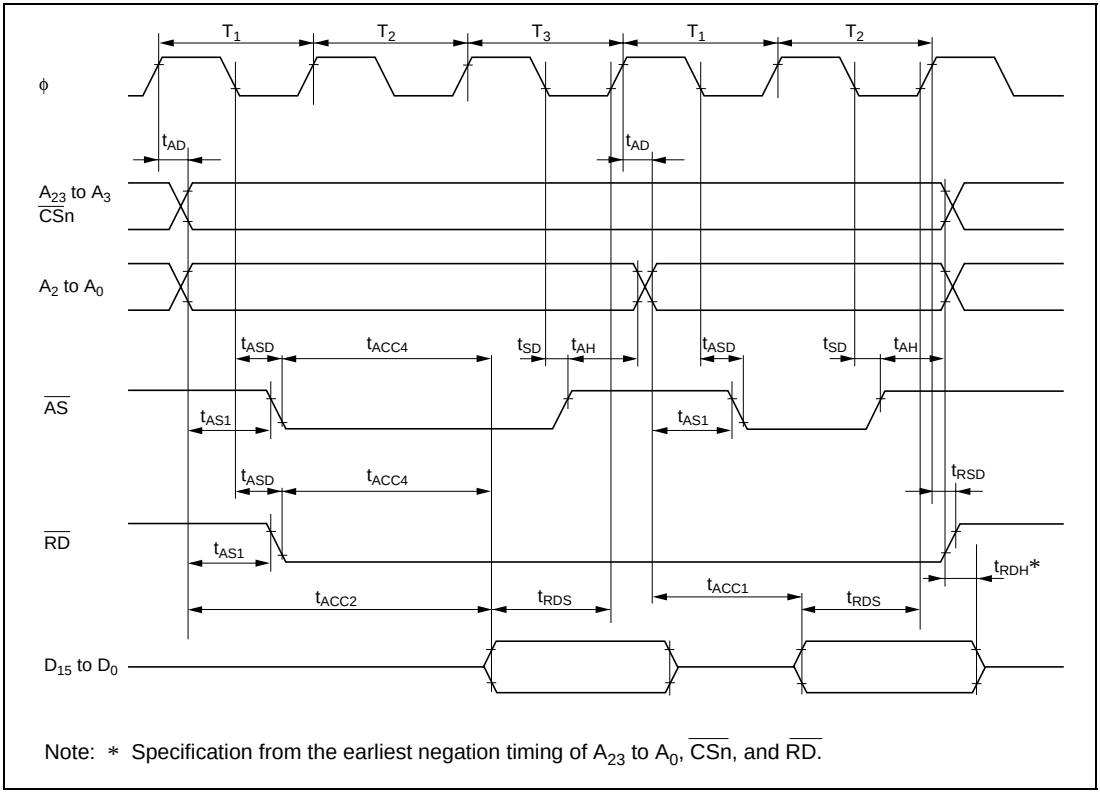


Figure 21.15 Basic Bus Cycle: three State Access with One Wait State



Note: * Specification from the earliest negation timing of A_{23} to A_0, $\overline{CSn}$, and $\overline{RD}$.

Figure 21.16 Burst ROM Access Timing: two State Access

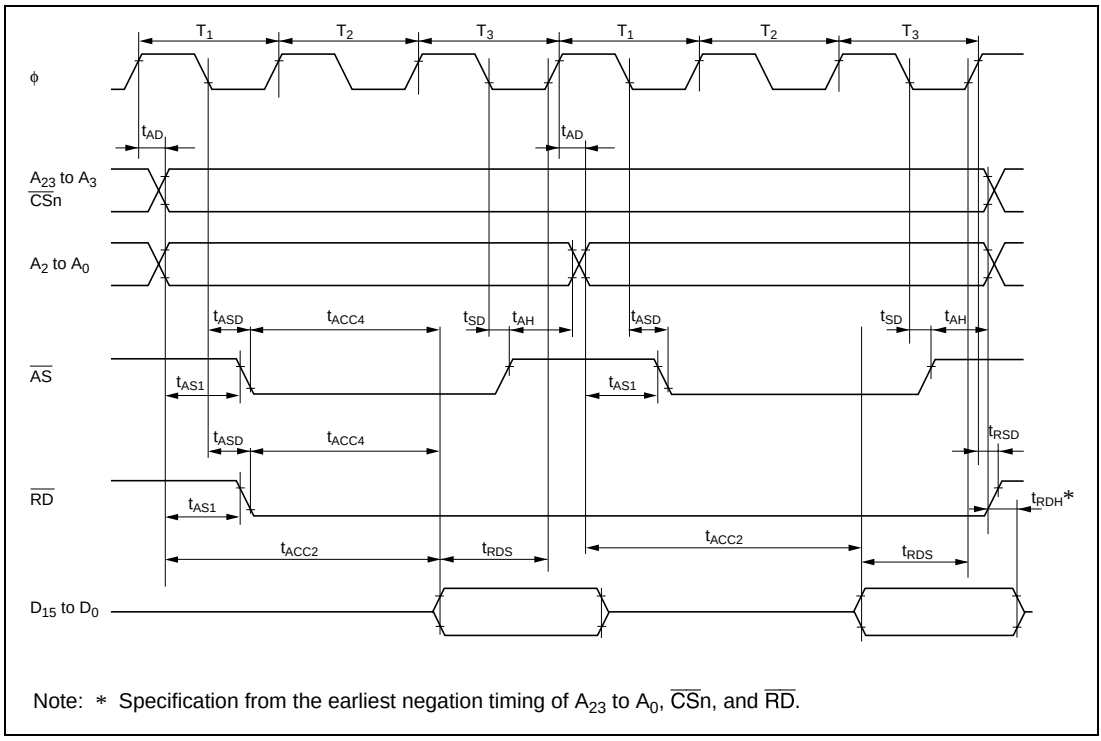


Figure 21.17 Burst ROM Access Timing: three State Access

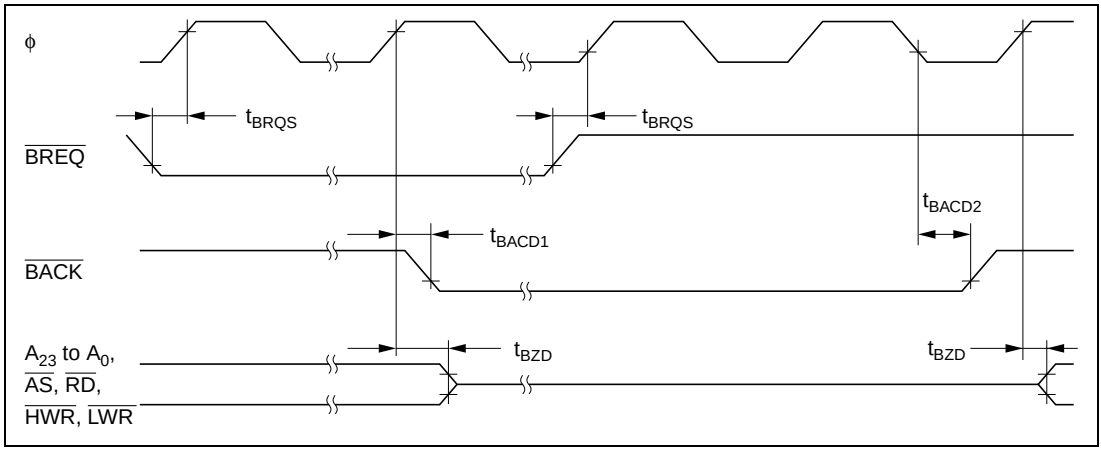
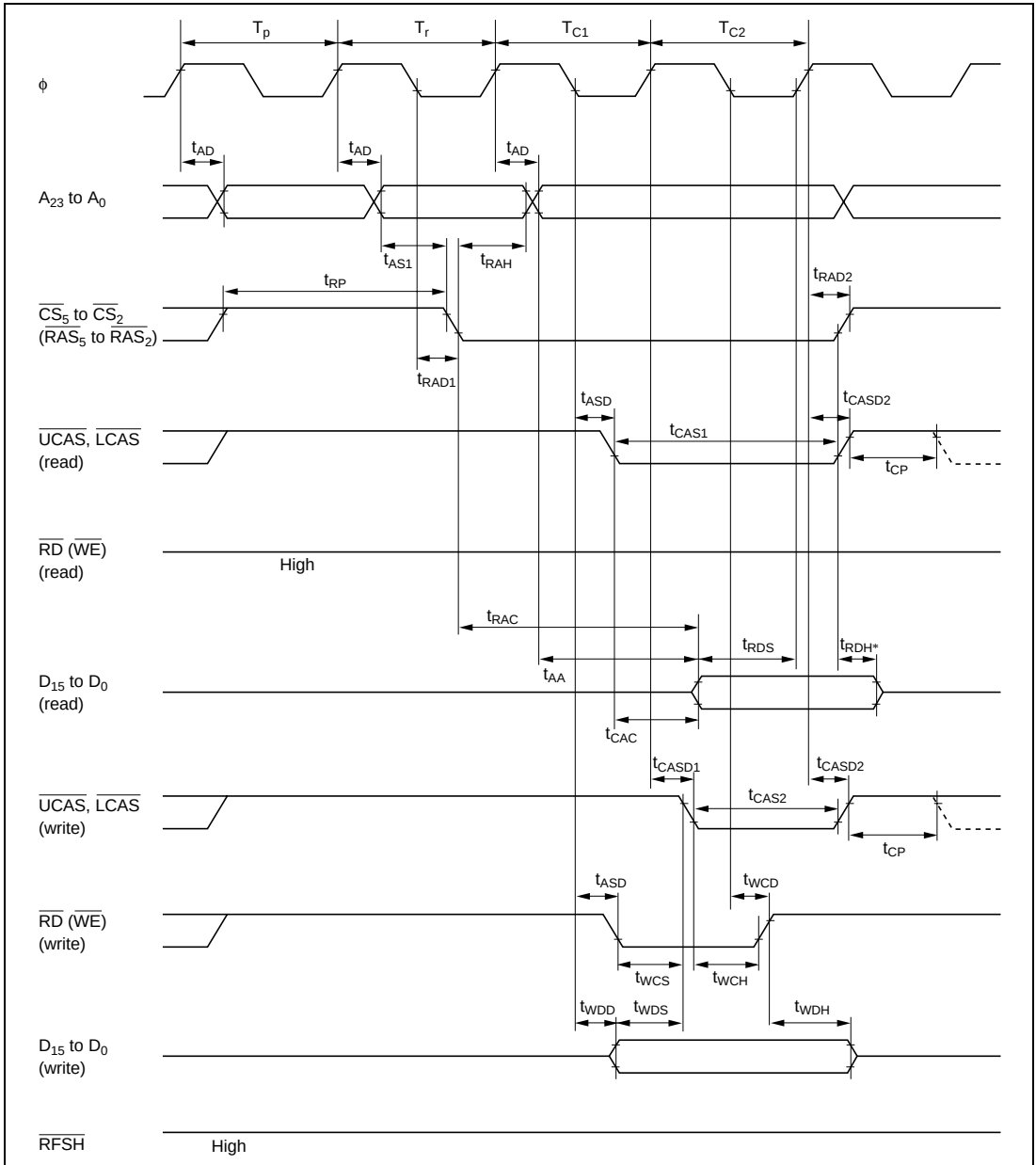


Figure 21.18 Bus-Release Mode Timing

21.4.4 DRAM Interface Bus Timing

DRAM interface bus timing is shown as follows:

- DRAM bus timing: read and write access
  Figure 21.19 shows the timing of the read and write access.
- DRAM bus timing: CAS before RAS refresh
  Figure 21.20 shows the timing of the CAS before RAS refresh.
- DRAM bus timing: self-refresh
  Figure 21.21 shows the timing of the self-refresh.



Note: * Specification from the earliest negation timing of $\overline{RAS}$ and $\overline{CAS}$.

Figure 21.19 DRAM Bus Timing (Read/Write)

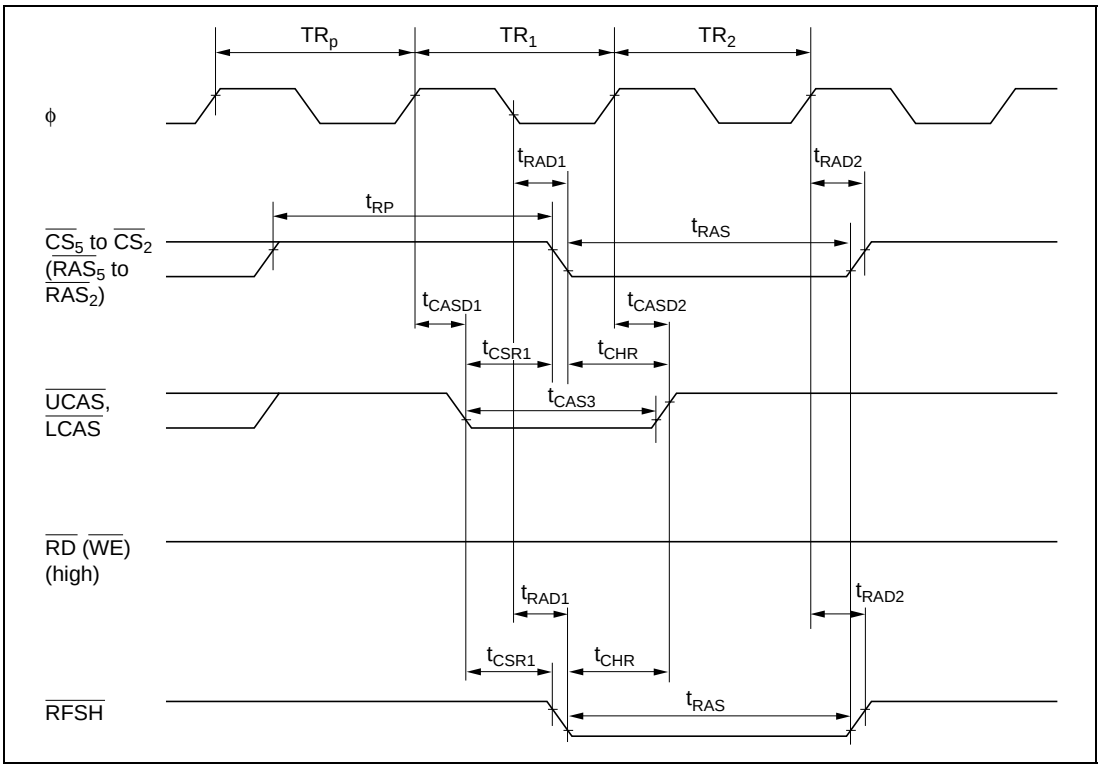


Figure 21.20 DRAM Bus Timing (CAS Before RAS Refresh)

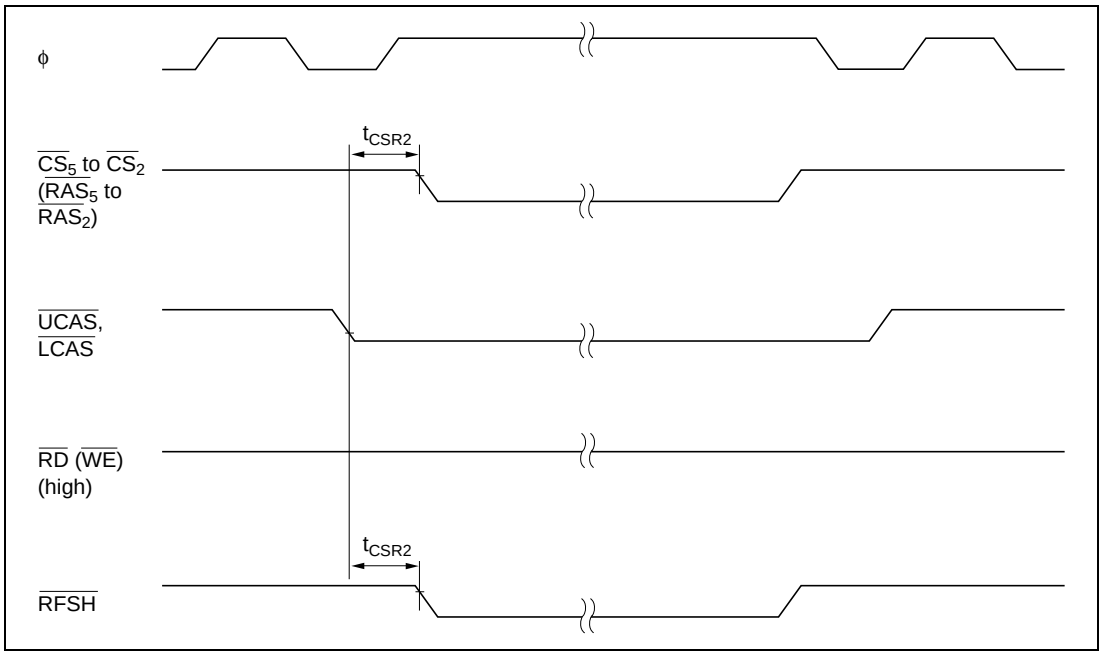


Figure 21.21 DRAM Bus Timing (Self-Refresh)

21.4.5 TPC and I/O Port Timing

Figure 21.22 shows the TPC and I/O port input/output timing.

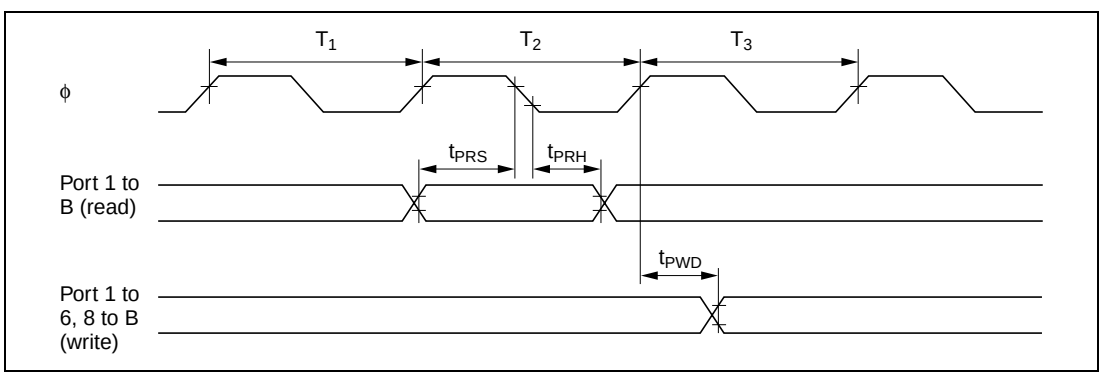


Figure 21.22 TPC and I/O Port Input/Output Timing

21.4.6 Timer Input/Output Timing

16-bit timer and 8-bit timer timing is shown below.

- Timer input/output timing
  Figure 21.23 shows the timer input/output timing.
- Timer external clock input timing
  Figure 21.24 shows the timer external clock input timing.

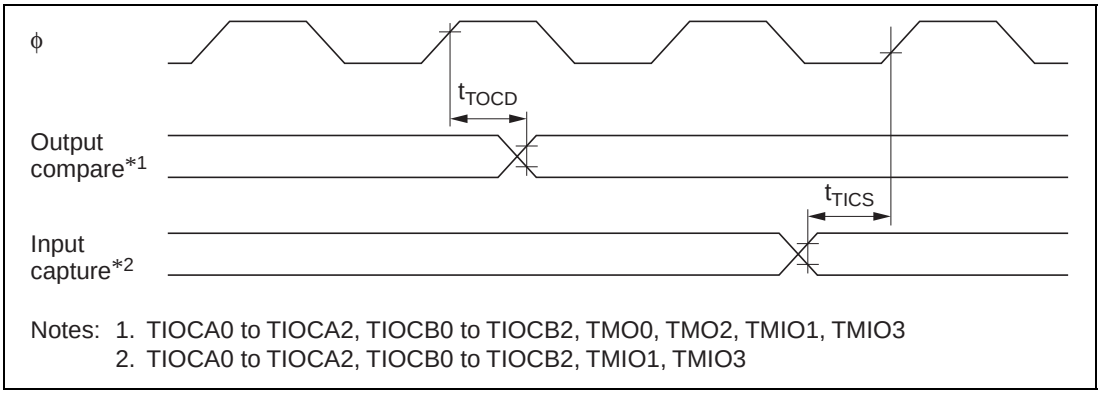


Figure 21.23 Timer Input/Output Timing

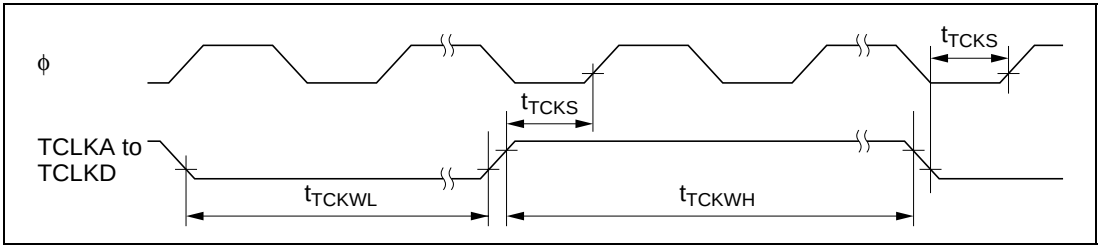


Figure 21.24 Timer External Clock Input Timing

21.4.7 SCI Input/Output Timing

SCI timing is shown as follows:

- SCI input clock timing
  Figure 21.25 shows the SCI input clock timing.
- SCI input/output timing (synchronous mode)
  Figure 21.26 shows the SCI input/output timing in synchronous mode.

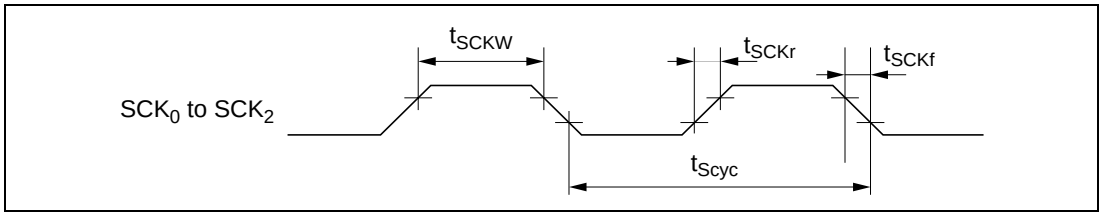


Figure 21.25 SCI Input Clock Timing

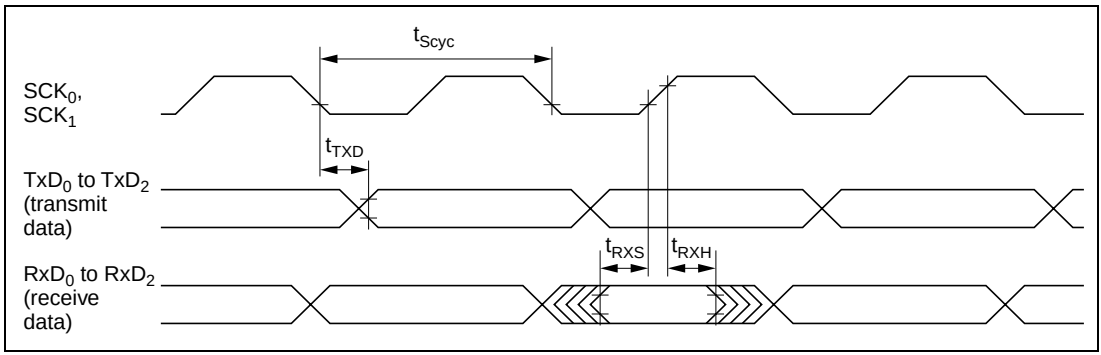


Figure 21.26 SCI Input/Output Timing in Synchronous Mode

21.4.8 DMAC Timing

DMAC timing is shown as follows.

- DMAC $\overline{\text{TEND}}$ output timing for 2 state access
  Figure 21.27 shows the DMAC $\overline{\text{TEND}}$ output timing for two state access.
- DMAC $\overline{\text{TEND}}$ output timing for 3 state access
  Figure 21.28 shows the DMAC $\overline{\text{TEND}}$ output timing for three state access.
- DMAC $\overline{\text{DREQ}}$ input timing
  Figure 21.29 shows DMAC $\overline{\text{DREQ}}$ input timing.

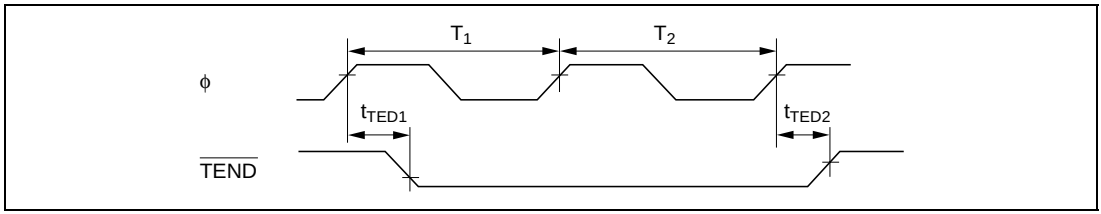


Figure 21.27 DMAC $\overline{\text{TEND}}$ Output Timing for two State Access

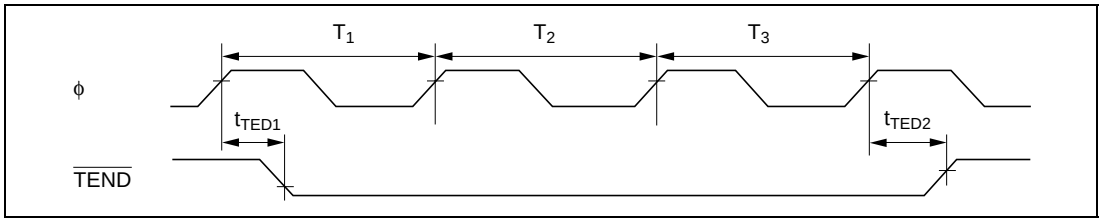


Figure 21.28 DMAC $\overline{\text{TEND}}$ Output Timing for three State Access

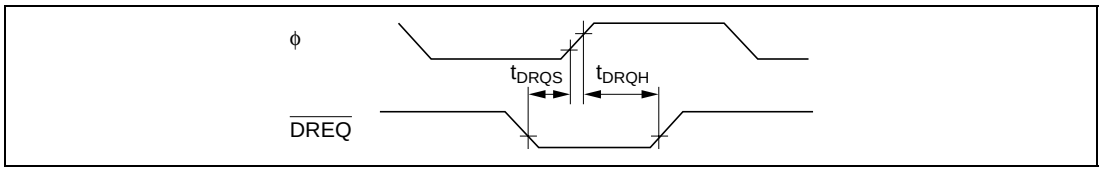
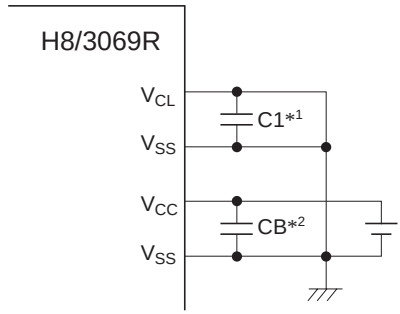


Figure 21.29 DMAC $\overline{\text{DREQ}}$ Input Timing

21.5 Usage Notes

Insert a capacitor (C1) between the V_{CL} and V_{SS} pins to stabilize the internal step-down voltage and a voltage stabilizing capacitor (CB) between the V_{CC} and V_{SS} pins. Figure 21.30 shows a wiring example.



Notes: 1. For C1, which is used to stabilize the internal step-down voltage, use a 0.1 µF laminated ceramic capacitor and place it close to the pins.
2. For CB, the voltage stabilizing capacitor, use a laminated ceramic capacitor rated at 0.1 µF to 0.47 µF (or five 0.1 µF capacitors connected in parallel) and place it close to the pins.

Figure 21.30 Method of Connecting Capacitors to V_{CL} and V_{CC} Pins

Appendix A Instruction Set

A.1 Instruction List

Operand Notation

Symbol	Description
Rd	General destination register
Rs	General source register
Rn	General register
ERd	General destination register (address register or 32-bit register)
ERs	General source register (address register or 32-bit register)
ERn	General register (32-bit register)
(EAd)	Destination operand
(EAs)	Source operand
PC	Program counter
SP	Stack pointer
CCR	Condition code register
N	N (negative) flag in CCR
Z	Z (zero) flag in CCR
V	V (overflow) flag in CCR
C	C (carry) flag in CCR
disp	Displacement
→	Transfer from the operand on the left to the operand on the right, or transition from the state on the left to the state on the right
+	Addition of the operands on both sides
–	Subtraction of the operand on the right from the operand on the left
×	Multiplication of the operands on both sides
÷	Division of the operand on the left by the operand on the right
∧	Logical AND of the operands on both sides
∨	Logical OR of the operands on both sides
⊕	Exclusive logical OR of the operands on both sides
¬	NOT (logical complement)
( ), < >	Contents of operand

Note: General registers include 8-bit registers (R0H to R7H and R0L to R7L) and 16-bit registers (R0 to R7 and E0 to E7).

Condition Code Notation

Symbol	Description
↕	Changed according to execution result
*	Undetermined (no guaranteed value)
0	Cleared to 0
1	Set to 1
—	Not affected by execution of the instruction
Δ	Varies depending on conditions, described in notes

Table A.1 Instruction Set

1. Data transfer instructions

Mnemonic	Operand Size	Addressing Mode and Instruction Length (bytes)									Operation	Condition Code						No. of States*1	
		#xx	Rn	@ERn	@(d, ERn)	@–ERn/@ERn+	@aa	@(d, PC)	@@aa	|		I	H	N	Z	V	C	Normal	Advanced
MOV.B #xx:8, Rd	B	2									#xx:8 → Rd8	—	—	↕	↕	0	—	2	
MOV.B Rs, Rd	B		2								Rs8 → Rd8	—	—	↕	↕	0	—	2	
MOV.B @ERs, Rd	B			2							@ERs → Rd8	—	—	↕	↕	0	—	4	
MOV.B @(d:16, ERs), Rd	B				4						@(d:16, ERs) → Rd8	—	—	↕	↕	0	—	6	
MOV.B @(d:24, ERs), Rd	B				8						@(d:24, ERs) → Rd8	—	—	↕	↕	0	—	10	
MOV.B @ERs+, Rd	B					2					@ERs → Rd8 ERs32+1 → ERs32	—	—	↕	↕	0	—	6	
MOV.B @aa:8, Rd	B						2				@aa:8 → Rd8	—	—	↕	↕	0	—	4	
MOV.B @aa:16, Rd	B						4				@aa:16 → Rd8	—	—	↕	↕	0	—	6	
MOV.B @aa:24, Rd	B						6				@aa:24 → Rd8	—	—	↕	↕	0	—	8	
MOV.B Rs, @ERd	B			2							Rs8 → @ERd	—	—	↕	↕	0	—	4	
MOV.B Rs, @(d:16, ERd)	B				4						Rs8 → @(d:16, ERd)	—	—	↕	↕	0	—	6	
MOV.B Rs, @(d:24, ERd)	B				8						Rs8 → @(d:24, ERd)	—	—	↕	↕	0	—	10	
MOV.B Rs, @–ERd	B					2					ERd32–1 → ERd32 Rs8 → @ERd	—	—	↕	↕	0	—	6	
MOV.B Rs, @aa:8	B						2				Rs8 → @aa:8	—	—	↕	↕	0	—	4	
MOV.B Rs, @aa:16	B						4				Rs8 → @aa:16	—	—	↕	↕	0	—	6	
MOV.B Rs, @aa:24	B						6				Rs8 → @aa:24	—	—	↕	↕	0	—	8	
MOV.W #xx:16, Rd	W	4									#xx:16 → Rd16	—	—	↕	↕	0	—	4	
MOV.W Rs, Rd	W		2								Rs16 → Rd16	—	—	↕	↕	0	—	2	
MOV.W @ERs, Rd	W			2							@ERs → Rd16	—	—	↕	↕	0	—	4	
MOV.W @(d:16, ERs), Rd	W				4						@(d:16, ERs) → Rd16	—	—	↕	↕	0	—	6	
MOV.W @(d:24, ERs), Rd	W				8						@(d:24, ERs) → Rd16	—	—	↕	↕	0	—	10	
MOV.W @ERs+, Rd	W					2					@ERs → Rd16 ERs32+2 → @ERd32	—	—	↕	↕	0	—	6	
MOV.W @aa:16, Rd	W						4				@aa:16 → Rd16	—	—	↕	↕	0	—	6	

Mnemonic	Operand Size	Addressing Mode and Instruction Length (bytes)									Operation	Condition Code						No. of States*1	
		#xx	Rn	@ERn	@(d, ERn)	@–ERn/@ERn+	@aa	@(d, PC)	@@aa	|		I	H	N	Z	V	C	Normal	Advanced
MOV.W @aa:24, Rd	W						6				@aa:24 → Rd16	—	—	↕	↕	0	—	8	
MOV.W Rs, @ERd	W			2							Rs16 → @ERd	—	—	↕	↕	0	—	4	
MOV.W Rs, @(d:16, ERd)	W				4						Rs16 → @(d:16, ERd)	—	—	↕	↕	0	—	6	
MOV.W Rs, @(d:24, ERd)	W				8						Rs16 → @(d:24, ERd)	—	—	↕	↕	0	—	10	
MOV.W Rs, @–ERd	W					2					ERd32–2 → ERd32 Rs16 → @ERd	—	—	↕	↕	0	—	6	
MOV.W Rs, @aa:16	W						4				Rs16 → @aa:16	—	—	↕	↕	0	—	6	
MOV.W Rs, @aa:24	W						6				Rs16 → @aa:24	—	—	↕	↕	0	—	8	
MOV.L #xx:32, Rd	L	6									#xx:32 → Rd32	—	—	↕	↕	0	—	6	
MOV.L ERs, ERd	L		2								ERs32 → ERd32	—	—	↕	↕	0	—	2	
MOV.L @ERs, ERd	L			4							@ERs → ERd32	—	—	↕	↕	0	—	8	
MOV.L @(d:16, ERs), ERd	L				6						@(d:16, ERs) → ERd32	—	—	↕	↕	0	—	10	
MOV.L @(d:24, ERs), ERd	L				10						@(d:24, ERs) → ERd32	—	—	↕	↕	0	—	14	
MOV.L @ERs+, ERd	L					4					@ERs → ERd32 ERs32+4 → ERs32	—	—	↕	↕	0	—	10	
MOV.L @aa:16, ERd	L						6				@aa:16 → ERd32	—	—	↕	↕	0	—	10	
MOV.L @aa:24, ERd	L						8				@aa:24 → ERd32	—	—	↕	↕	0	—	12	
MOV.L ERs, @ERd	L			4							ERs32 → @ERd	—	—	↕	↕	0	—	8	
MOV.L ERs, @(d:16, ERd)	L				6						ERs32 → @(d:16, ERd)	—	—	↕	↕	0	—	10	
MOV.L ERs, @(d:24, ERd)	L				10						ERs32 → @(d:24, ERd)	—	—	↕	↕	0	—	14	
MOV.L ERs, @–ERd	L					4					ERd32–4 → ERd32 ERs32 → @ERd	—	—	↕	↕	0	—	10	
MOV.L ERs, @aa:16	L						6				ERs32 → @aa:16	—	—	↕	↕	0	—	10	
MOV.L ERs, @aa:24	L						8				ERs32 → @aa:24	—	—	↕	↕	0	—	12	
POP.W Rn	W									2	@SP → Rn16 SP+2 → SP	—	—	↕	↕	0	—	6	
POP.L ERn	L									4	@SP → ERn32 SP+4 → SP	—	—	↕	↕	0	—	10	

Mnemonic	Operand Size	Addressing Mode and Instruction Length (bytes)									Operation	Condition Code						No. of States*1	
		#xx	Rn	@ERn	@(d, ERn)	@–ERn/@ERn+	@aa	@(d, PC)	@@aa	|		I	H	N	Z	V	C	Normal	Advanced
PUSH.W Rn	W									2	SP–2 → SP Rn16 → @SP	—	—	↕	↕	0	—	6	
PUSH.L ERn	L									4	SP–4 → SP ERn32 → @SP	—	—	↕	↕	0	—	10	
MOVFPE @aa:16, Rd	B						4				Cannot be used in the H8/3069R	Cannot be used in the H8/3069R							
MOVTPE Rs, @aa:16	B						4				Cannot be used in the H8/3069R	Cannot be used in the H8/3069R							

2. Arithmetic instructions

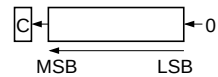
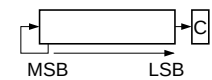
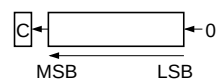
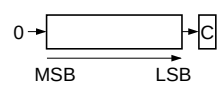
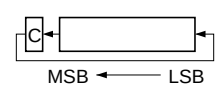
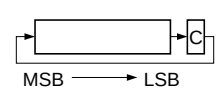
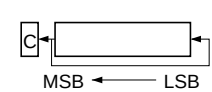
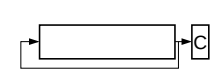
Mnemonic	Operand Size	Addressing Mode and Instruction Length (bytes)									Operation	Condition Code						No. of States*1	
		#xx	Rn	@ERn	@(d, ERn)	@–ERn/@ERn+	@aa	@(d, PC)	@@aa	|		I	H	N	Z	V	C	Normal	Advanced
ADD.B #xx:8, Rd	B	2									Rd8+#xx:8 → Rd8	—	↕	↕	↕	↕	↕	2	
ADD.B Rs, Rd	B		2								Rd8+Rs8 → Rd8	—	↕	↕	↕	↕	↕	2	
ADD.W #xx:16, Rd	W	4									Rd16+#xx:16 → Rd16	—	(1)	↕	↕	↕	↕	4	
ADD.W Rs, Rd	W		2								Rd16+Rs16 → Rd16	—	(1)	↕	↕	↕	↕	2	
ADD.L #xx:32, ERd	L	6									ERd32+#xx:32 → ERd32	—	(2)	↕	↕	↕	↕	6	
ADD.L ERs, ERd	L		2								ERd32+ERs32 → ERd32	—	(2)	↕	↕	↕	↕	2	
ADDX.B #xx:8, Rd	B	2									Rd8+#xx:8 +C → Rd8	—	↕	↕	(3)	↕	↕	2	
ADDX.B Rs, Rd	B		2								Rd8+Rs8 +C → Rd8	—	↕	↕	(3)	↕	↕	2	
ADDS.L #1, ERd	L		2								ERd32+1 → ERd32	—	—	—	—	—	—	2	
ADDS.L #2, ERd	L		2								ERd32+2 → ERd32	—	—	—	—	—	—	2	
ADDS.L #4, ERd	L		2								ERd32+4 → ERd32	—	—	—	—	—	—	2	
INC.B Rd	B		2								Rd8+1 → Rd8	—	—	↕	↕	↕	—	2	
INC.W #1, Rd	W		2								Rd16+1 → Rd16	—	—	↕	↕	↕	—	2	
INC.W #2, Rd	W		2								Rd16+2 → Rd16	—	—	↕	↕	↕	—	2	

Mnemonic	Operand Size	Addressing Mode and Instruction Length (bytes)									Operation	Condition Code						No. of States*1	
		#xx	Rn	@ERn	@(d, ERn)	@–ERn/@ERn+	@aa	@(d, PC)	@@aa	|		I	H	N	Z	V	C	Normal	Advanced
INC.L #1, ERd	L		2								ERd32+1 → ERd32	—	—	↕	↕		—	2	
INC.L #2, ERd	L		2								ERd32+2 → ERd32	—	—	↕	↕		—	2	
DAA Rd	B		2								Rd8 decimal adjust → Rd8	—	*	↕	↕	*	—	2	
SUB.B Rs, Rd	B		2								Rd8–Rs8 → Rd8	—	↕	↕	↕	↕	↕	2	
SUB.W #xx:16, Rd	W	4									Rd16–#xx:16 → Rd16	—	(1)	↕	↕	↕	↕	4	
SUB.W Rs, Rd	W		2								Rd16–Rs16 → Rd16	—	(1)	↕	↕	↕	↕	2	
SUB.L #xx:32, ERd	L	6									ERd32–#xx:32 → ERd32	—	(2)	↕	↕	↕	↕	6	
SUB.L ERs, ERd	L		2								ERd32–ERs32 → ERd32	—	(2)	↕	↕	↕	↕	2	
SUBX.B #xx:8, Rd	B	2									Rd8–#xx:8–C → Rd8	—	↕	↕	(3)	↕	↕	2	
SUBX.B Rs, Rd	B		2								Rd8–Rs8–C → Rd8	—	↕	↕	(3)	↕	↕	2	
SUBS.L #1, ERd	L		2								ERd32–1 → ERd32	—	—	—	—	—	—	2	
SUBS.L #2, ERd	L		2								ERd32–2 → ERd32	—	—	—	—	—	—	2	
SUBS.L #4, ERd	L		2								ERd32–4 → ERd32	—	—	—	—	—	—	2	
DEC.B Rd	B		2								Rd8–1 → Rd8	—	—	↕	↕	↕	—	2	
DEC.W #1, Rd	W		2								Rd16–1 → Rd16	—	—	↕	↕	↕	—	2	
DEC.W #2, Rd	W		2								Rd16–2 → Rd16	—	—	↕	↕	↕	—	2	
DEC.L #1, ERd	L		2								ERd32–1 → ERd32	—	—	↕	↕	↕	—	2	
DEC.L #2, ERd	L		2								ERd32–2 → ERd32	—	—	↕	↕	↕	—	2	
DAS.Rd	B		2								Rd8 decimal adjust → Rd8	—	*	↕	↕	*	—	2	
MULXU. B Rs, Rd	B		2								Rd8 × Rs8 → Rd16 (unsigned multiplication)	—	—	—	—	—	—	14	
MULXU. W Rs, ERd	W		2								Rd16 × Rs16 → ERd32 (unsigned multiplication)	—	—	—	—	—	—	22	
MULXS. B Rs, Rd	B		4								Rd8 × Rs8 → Rd16 (signed multiplication)	—	—	↕	↕	—	—	16	
MULXS. W Rs, ERd	W		4								Rd16 × Rs16 → ERd32 (signed multiplication)	—	—	↕	↕	—	—	24	
DIVXU. B Rs, Rd	B		2								Rd16 ÷ Rs8 → Rd16 (RdH: remainder, RdL: quotient) (unsigned division)	—	—	(6)	(7)	—	—	14	

Mnemonic	Operand Size	Addressing Mode and Instruction Length (bytes)									Operation	Condition Code						No. of States*1	
		#xx	Rn	@ERn	@(d, ERn)	@–ERn/@ERn+	@aa	@(d, PC)	@@aa	|		I	H	N	Z	V	C	Normal	Advanced
DIVXU. W Rs, ERd	W		2								ERd32 ÷ Rs16 → ERd32 (Ed: remainder, Rd: quotient) (unsigned division)	—	—	(6)	(7)	—	—	22	
DIVXS. B Rs, Rd	B		4								Rd16 ÷ Rs8 → Rd16 (RdH: remainder, RdL: quotient) (signed division)	—	—	(8)	(7)	—	—	16	
DIVXS. W Rs, ERd	W		4								ERd32 ÷ Rs16 → ERd32 (Ed: remainder, Rd: quotient) (signed division)	—	—	(8)	(7)	—	—	24	
CMP.B #xx:8, Rd	B	2									Rd8–#xx:8	—	↕	↕	↕	↕	↕	2	
CMP.B Rs, Rd	B		2								Rd8–Rs8	—	↕	↕	↕	↕	↕	2	
CMP.W #xx:16, Rd	W	4									Rd16–#xx:16	—	(1)	↕	↕	↕	↕	4	
CMP.W Rs, Rd	W		2								Rd16–Rs16	—	(1)	↕	↕	↕	↕	2	
CMP.L #xx:32, ERd	L	6									ERd32–#xx:32	—	(2)	↕	↕	↕	↕	6	
CMP.L ERs, ERd	L		2								ERd32–ERs32	—	(2)	↕	↕	↕	↕	2	
NEG.B Rd	B		2								0–Rd8 → Rd8	—	↕	↕	↕	↕	↕	2	
NEG.W Rd	W		2								0–Rd16 → Rd16	—	↕	↕	↕	↕	↕	2	
NEG.L ERd	L		2								0–ERd32 → ERd32	—	↕	↕	↕	↕	↕	2	
EXTU.W Rd	W		2								0 → (<bits 15 to 8> of Rd16)	—	—	0	↕	0	—	2	
EXTU.L ERd	L		2								0 → (<bits 31 to 16> of ERd32)	—	—	0	↕	0	—	2	
EXTS.W Rd	W		2								(<bit 7> of Rd16) → (<bits 15 to 8> of Rd16)	—	—	↕	↕	0	↕	2	
EXTS.L ERd	L		2								(<bit 15> of ERd32) → (<bits 31 to 16> of ERd32)	—	—	↕	↕	0	—	2	

Mnemonic	Operand Size	Addressing Mode and Instruction Length (bytes)									Operation	Condition Code						No. of States*1	
		#xx	Rn	@ERn	@(d, ERn)	@–ERn/@ERn+	@aa	@(d, PC)	@@aa	|		I	H	N	Z	V	C	Normal	Advanced
AND.B #xx:8, Rd	B	2									Rd8∧#xx:8 → Rd8	—	—	↕	↕	0	—	2	
AND.B Rs, Rd	B		2								Rd8∧Rs8 → Rd8	—	—	↕	↕	0	—	2	
AND.W #xx:16, Rd	W	4									Rd16∧#xx:16 → Rd16	—	—	↕	↕	0	—	4	
AND.W Rs, Rd	W		2								Rd16∧Rs16 → Rd16	—	—	↕	↕	0	—	2	
AND.L #xx:32, ERd	L	6									ERd32∧#xx:32 → ERd32	—	—	↕	↕	0	—	6	
AND.L ERs, ERd	L		4								ERd32∧ERs32 → ERd32	—	—	↕	↕	0	—	4	
OR.B #xx:8, Rd	B	2									Rd8∨#xx:8 → Rd8	—	—	↕	↕	0	—	2	
OR.B Rs, Rd	B		2								Rd8∨Rs8 → Rd8	—	—	↕	↕	0	—	2	
OR.W #xx:16, Rd	W	4									Rd16∨#xx:16 → Rd16	—	—	↕	↕	0	—	4	
OR.W Rs, Rd	W		2								Rd16∨Rs16 → Rd16	—	—	↕	↕	0	—	2	
OR.L #xx:32, ERd	L	6									ERd32∨#xx:32 → ERd32	—	—	↕	↕	0	—	6	
OR.L ERs, ERd	L		4								ERd32∨ERs32 → ERd32	—	—	↕	↕	0	—	4	
XOR.B #xx:8, Rd	B	2									Rd8⊕#xx:8 → Rd8	—	—	↕	↕	0	—	2	
XOR.B Rs, Rd	B		2								Rd8⊕Rs8 → Rd8	—	—	↕	↕	0	—	2	
XOR.W #xx:16, Rd	W	4									Rd16⊕#xx:16 → Rd16	—	—	↕	↕	0	—	4	
XOR.W Rs, Rd	W		2								Rd16⊕Rs16 → Rd16	—	—	↕	↕	0	—	2	
XOR.L #xx:32, ERd	L	6									ERd32⊕#xx:32 → ERd32	—	—	↕	↕	0	—	6	
XOR.L ERs, ERd	L		4								ERd32⊕ERs32 → ERd32	—	—	↕	↕	0	—	4	
NOT.B Rd	B		2								¬ Rd8 → Rd8	—	—	↕	↕	0	—	2	
NOT.W Rd	W		2								¬ Rd16 → Rd16	—	—	↕	↕	0	—	2	
NOT.L ERd	L		2								¬ Rd32 → Rd32	—	—	↕	↕	0	—	2	

4. Shift instructions

Mnemonic	Operand Size	Addressing Mode and Instruction Length (bytes)									Operation	Condition Code						No. of States*1	
		#xx	Rn	@ERn	@(d, ERn)	@–ERn/@ERn+	@aa	@(d, PC)	@@aa	—		I	H	N	Z	V	C	Normal	Advanced
SHAL.B Rd	B		2									—	—	↕	↕	↕	↕	2	
SHAL.W Rd	W		2									—	—	↕	↕	↕	↕	2	
SHAL.L ERd	L		2									—	—	↕	↕	↕	↕	2	
SHAR.B Rd	B		2									—	—	↕	↕	0	↕	2	
SHAR.W Rd	W		2									—	—	↕	↕	0	↕	2	
SHAR.L ERd	L		2									—	—	↕	↕	0	↕	2	
SHLL.B Rd	B		2									—	—	↕	↕	0	↕	2	
SHLL.W Rd	W		2									—	—	↕	↕	0	↕	2	
SHLL.L ERd	L		2									—	—	↕	↕	0	↕	2	
SHLR.B Rd	B		2									—	—	↕	↕	0	↕	2	
SHLR.W Rd	W		2									—	—	↕	↕	0	↕	2	
SHLR.L ERd	L		2									—	—	↕	↕	0	↕	2	
ROTXL.B Rd	B		2									—	—	↕	↕	0	↕	2	
ROTXL.W Rd	W		2									—	—	↕	↕	0	↕	2	
ROTXL.L ERd	L		2									—	—	↕	↕	0	↕	2	
ROTXR.B Rd	B		2									—	—	↕	↕	0	↕	2	
ROTXR.W Rd	W		2									—	—	↕	↕	0	↕	2	
ROTXR.L ERd	L		2									—	—	↕	↕	0	↕	2	
ROTL.B Rd	B		2									—	—	↕	↕	0	↕	2	
ROTL.W Rd	W		2									—	—	↕	↕	0	↕	2	
ROTL.L ERd	L		2									—	—	↕	↕	0	↕	2	
ROTR.B Rd	B		2									—	—	↕	↕	0	↕	2	
ROTR.W Rd	W		2									—	—	↕	↕	0	↕	2	
ROTR.L ERd	L		2									—	—	↕	↕	0	↕	2	

5. Bit manipulation instructions

Mnemonic	Operand Size	Addressing Mode and Instruction Length (bytes)									Operation	Condition Code						No. of States*1	
		#xx	Rn	@ERn	@(d, ERn)	@–ERn/@ERn+	@aa	@(d, PC)	@@aa	|		I	H	N	Z	V	C	Normal	Advanced
BSET #xx:3, Rd	B		2								(#xx:3 of Rd8) ← 1	—	—	—	—	—	—	2	
BSET #xx:3, @ERd	B			4							(#xx:3 of @ERd) ← 1	—	—	—	—	—	—	8	
BSET #xx:3, @aa:8	B						4				(#xx:3 of @aa:8) ← 1	—	—	—	—	—	—	8	
BSET Rn, Rd	B		2								(Rn8 of Rd8) ← 1	—	—	—	—	—	—	2	
BSET Rn, @ERd	B			4							(Rn8 of @ERd) ← 1	—	—	—	—	—	—	8	
BSET Rn, @aa:8	B						4				(Rn8 of @aa:8) ← 1	—	—	—	—	—	—	8	
BCLR #xx:3, Rd	B		2								(#xx:3 of Rd8) ← 0	—	—	—	—	—	—	2	
BCLR #xx:3, @ERd	B			4							(#xx:3 of @ERd) ← 0	—	—	—	—	—	—	8	
BCLR #xx:3, @aa:8	B						4				(#xx:3 of @aa:8) ← 0	—	—	—	—	—	—	8	
BCLR Rn, Rd	B		2								(Rn8 of Rd8) ← 0	—	—	—	—	—	—	2	
BCLR Rn, @ERd	B			4							(Rn8 of @ERd) ← 0	—	—	—	—	—	—	8	
BCLR Rn, @aa:8	B						4				(Rn8 of @aa:8) ← 0	—	—	—	—	—	—	8	
BNOT #xx:3, Rd	B		2								(#xx:3 of Rd8) ← ¬ (#xx:3 of Rd8)	—	—	—	—	—	—	2	
BNOT #xx:3, @ERd	B			4							(#xx:3 of @ERd) ← ¬ (#xx:3 of @ERd)	—	—	—	—	—	—	8	
BNOT #xx:3, @aa:8	B						4				(#xx:3 of @aa:8) ← ¬ (#xx:3 of @aa:8)	—	—	—	—	—	—	8	
BNOT Rn, Rd	B		2								(Rn8 of Rd8) ← ¬ (Rn8 of Rd8)	—	—	—	—	—	—	2	
BNOT Rn, @ERd	B			4							(Rn8 of @ERd) ← ¬ (Rn8 of @ERd)	—	—	—	—	—	—	8	
BNOT Rn, @aa:8	B						4				(Rn8 of @aa:8) ← ¬ (Rn8 of @aa:8)	—	—	—	—	—	—	8	
BTST #xx:3, Rd	B		2								¬ (#xx:3 of Rd8) → Z	—	—	—	↕	—	—	2	
BTST #xx:3, @ERd	B			4							¬ (#xx:3 of @ERd) → Z	—	—	—	↕	—	—	6	
BTST #xx:3, @aa:8	B						4				¬ (#xx:3 of @aa:8) → Z	—	—	—	↕	—	—	6	
BTST Rn, Rd	B		2								¬ (Rn8 of @Rd8) → Z	—	—	—	↕	—	—	2	
BTST Rn, @ERd	B			4							¬ (Rn8 of @ERd) → Z	—	—	—	↕	—	—	6	
BTST Rn, @aa:8	B						4				¬ (Rn8 of @aa:8) → Z	—	—	—	↕	—	—	6	
BLD #xx:3, Rd	B		2								(#xx:3 of Rd8) → C	—	—	—	—	—	↕	2	

Mnemonic	Operand Size	Addressing Mode and Instruction Length (bytes)									Operation	Condition Code						No. of States*1	
		#xx	Rn	@ERn	@(d, ERn)	@–ERn/@ERn+	@aa	@(d, PC)	@@aa	|		I	H	N	Z	V	C	Normal	Advanced
BLD #xx:3, @ERd	B			4							(#xx:3 of @ERd) → C	—	—	—	—	—	↕	6	
BLD #xx:3, @aa:8	B						4				(#xx:3 of @aa:8) → C	—	—	—	—	—	↕	6	
BILD #xx:3, Rd	B		2								¬ (#xx:3 of Rd8) → C	—	—	—	—	—	↕	2	
BILD #xx:3, @ERd	B			4							¬ (#xx:3 of @ERd) → C	—	—	—	—	—	↕	6	
BILD #xx:3, @aa:8	B						4				¬ (#xx:3 of @aa:8) → C	—	—	—	—	—	↕	6	
BST #xx:3, Rd	B		2								C → (#xx:3 of Rd8)	—	—	—	—	—	—	2	
BST #xx:3, @ERd	B			4							C → (#xx:3 of @ERd24)	—	—	—	—	—	—	8	
BST #xx:3, @aa:8	B						4				C → (#xx:3 of @aa:8)	—	—	—	—	—	—	8	
BIST #xx:3, Rd	B		2								¬ C → (#xx:3 of Rd8)	—	—	—	—	—	—	2	
BIST #xx:3, @ERd	B			4							¬ C → (#xx:3 of @ERd24)	—	—	—	—	—	—	8	
BIST #xx:3, @aa:8	B						4				¬ C → (#xx:3 of @aa:8)	—	—	—	—	—	—	8	
BAND #xx:3, Rd	B		2								C∧(#xx:3 of Rd8) → C	—	—	—	—	—	↕	2	
BAND #xx:3, @ERd	B			4							C∧(#xx:3 of @ERd24) → C	—	—	—	—	—	↕	6	
BAND #xx:3, @aa:8	B						4				C∧(#xx:3 of @aa:8) → C	—	—	—	—	—	↕	6	
BIAND #xx:3, Rd	B		2								C∧ ¬ (#xx:3 of Rd8) → C	—	—	—	—	—	↕	2	
BIAND #xx:3, @ERd	B			4							C∧ ¬ (#xx:3 of @ERd24) → C	—	—	—	—	—	↕	6	
BIAND #xx:3, @aa:8	B						4				C∧ ¬ (#xx:3 of @aa:8) → C	—	—	—	—	—	↕	6	
BOR #xx:3, Rd	B		2								C∨(#xx:3 of Rd8) → C	—	—	—	—	—	↕	2	
BOR #xx:3, @ERd	B			4							C∨(#xx:3 of @ERd24) → C	—	—	—	—	—	↕	6	
BOR #xx:3, @aa:8	B						4				C∨(#xx:3 of @aa:8) → C	—	—	—	—	—	↕	6	
BIOR #xx:3, Rd	B		2								C∨ ¬ (#xx:3 of Rd8) → C	—	—	—	—	—	↕	2	
BIOR #xx:3, @ERd	B			4							C∨ ¬ (#xx:3 of @ERd24) → C	—	—	—	—	—	↕	6	
BIOR #xx:3, @aa:8	B						4				C∨ ¬ (#xx:3 of @aa:8) → C	—	—	—	—	—	↕	6	
BXOR #xx:3, Rd	B		2								C⊕(#xx:3 of Rd8) → C	—	—	—	—	—	↕	2	
BXOR #xx:3, @ERd	B			4							C⊕(#xx:3 of @ERd24) → C	—	—	—	—	—	↕	6	
BXOR #xx:3, @aa:8	B						4				C⊕(#xx:3 of @aa:8) → C	—	—	—	—	—	↕	6	
BIXOR #xx:3, Rd	B		2								C⊕ ¬ (#xx:3 of Rd8) → C	—	—	—	—	—	↕	2	
BIXOR #xx:3, @ERd	B			4							C⊕ ¬ (#xx:3 of @ERd24) → C	—	—	—	—	—	↕	6	
BIXOR #xx:3, @aa:8	B						4				C⊕ ¬ (#xx:3 of @aa:8) → C	—	—	—	—	—	↕	6	

Mnemonic	Operand Size	Addressing Mode and Instruction Length (bytes)									Operation	Branch Condition	Condition Code						No. of States*1	
		#xx	Rn	@ERn	@(d, ERn)	@–ERn/@ERn+	@aa	@(d, PC)	@@aa	|			I	H	N	Z	V	C	Normal	Advanced
BRA d:8 (BT d:8)	—							2			If condition is true then PC ← PC+d else next;	Always	—	—	—	—	—	—	4	
BRA d:16 (BT d:16)	—							4					—	—	—	—	—	—	6	
BRN d:8 (BF d:8)	—							2				Never	—	—	—	—	—	—	4	
BRN d:16 (BF d:16)	—							4					—	—	—	—	—	—	6	
BHI d:8	—							2				C ∕ Z = 0	—	—	—	—	—	—	4	
BHI d:16	—							4					—	—	—	—	—	—	6	
BLS d:8	—							2				C ∕ Z = 1	—	—	—	—	—	—	4	
BLS d:16	—							4					—	—	—	—	—	—	6	
BCC d:8 (BHS d:8)	—							2				C = 0	—	—	—	—	—	—	4	
BCC d:16 (BHS d:16)	—							4					—	—	—	—	—	—	6	
BCS d:8 (BLO d:8)	—							2				C = 1	—	—	—	—	—	—	4	
BCS d:16 (BLO d:16)	—							4					—	—	—	—	—	—	6	
BNE d:8	—							2				Z = 0	—	—	—	—	—	—	4	
BNE d:16	—							4					—	—	—	—	—	—	6	
BEQ d:8	—							2				Z = 1	—	—	—	—	—	—	4	
BEQ d:16	—							4					—	—	—	—	—	—	6	
BVC d:8	—							2				V = 0	—	—	—	—	—	—	4	
BVC d:16	—							4					—	—	—	—	—	—	6	
BVS d:8	—							2				V = 1	—	—	—	—	—	—	4	
BVS d:16	—							4					—	—	—	—	—	—	6	
BPL d:8	—							2				N = 0	—	—	—	—	—	—	4	
BPL d:16	—							4					—	—	—	—	—	—	6	
BMI d:8	—							2				N = 1	—	—	—	—	—	—	4	
BMI d:16	—							4					—	—	—	—	—	—	6	
BGE d:8	—							2				N⊕V = 0	—	—	—	—	—	—	4	
BGE d:16	—							4					—	—	—	—	—	—	6	
BLT d:8	—							2				N⊕V = 1	—	—	—	—	—	—	4	
BLT d:16	—							4					—	—	—	—	—	—	6	
BGT d:8	—							2				Z ∕ (N⊕V) = 0	—	—	—	—	—	—	4	
BGT d:16	—							4					—	—	—	—	—	—	6	

Mnemonic	Operand Size	Addressing Mode and Instruction Length (bytes)									Operation	Branch Condition	Condition Code						No. of States*1	
		#xx	Rn	@ERn	@(d, ERn)	@–ERn/@ERn+	@aa	@(d, PC)	@@aa	|			I	H	N	Z	V	C	Normal	Advanced
BLE d:8	—							2			If condition is true then PC ← PC+d else next;	Z∕(N⊕V) = 1	—	—	—	—	—	—	4	
BLE d:16	—							4					—	—	—	—	—	—	6	
JMP @ERn	—			2							PC ← ERn		—	—	—	—	—	—	4	
JMP @aa:24	—						4				PC ← aa:24		—	—	—	—	—	—	6	
JMP @@aa:8	—								2		PC ← @aa:8		—	—	—	—	—	—	8	10
BSR d:8	—							2			PC → @–SP PC ← PC+d:8		—	—	—	—	—	—	6	8
BSR d:16	—							4			PC → @–SP PC ← PC+d:16		—	—	—	—	—	—	8	10
JSR @ERn	—			2							PC → @–SP PC ← @ERn		—	—	—	—	—	—	6	8
JSR @aa:24	—						4				PC → @–SP PC ← @aa:24		—	—	—	—	—	—	8	10
JSR @@aa:8	—								2		PC → @–SP PC ← @aa:8		—	—	—	—	—	—	8	12
RTS	—									2	PC ← @SP+		—	—	—	—	—	—	8	10

7. System control instructions

Mnemonic	Operand Size	Addressing Mode and Instruction Length (bytes)									Operation	Condition Code						No. of States*1	
		#xx	Rn	@ERn	@(d, ERn)	@–ERn/@ERn+	@aa	@(d, PC)	@@aa	|		I	H	N	Z	V	C	Normal	Advanced
TRAPA #x:2	—									2	PC → @–SP CCR → @–SP <vector> → PC	1	—	—	—	—	—	14	16
RTE	—										CCR ← @SP+ PC ← @SP+	↕	↕	↕	↕	↕	↕	10	
SLEEP	—										Transition to powerdown state	—	—	—	—	—	—	2	
LDC #xx:8, CCR	B	2									#xx:8 → CCR	↕	↕	↕	↕	↕	↕	2	
LDC Rs, CCR	B		2								Rs8 → CCR	↕	↕	↕	↕	↕	↕	2	
LDC @ERs, CCR	W			4							@ERs → CCR	↕	↕	↕	↕	↕	↕	6	
LDC @(d:16, ERs), CCR	W				6						@(d:16, ERs) → CCR	↕	↕	↕	↕	↕	↕	8	
LDC @(d:24, ERs), CCR	W				10						@(d:24, ERs) → CCR	↕	↕	↕	↕	↕	↕	12	
LDC @ERs+, CCR	W					4					@ERs → CCR ERs32+2 → ERs32	↕	↕	↕	↕	↕	↕	8	
LDC @aa:16, CCR	W						6				@aa:16 → CCR	↕	↕	↕	↕	↕	↕	8	
LDC @aa:24, CCR	W						8				@aa:24 → CCR	↕	↕	↕	↕	↕	↕	10	
STC CCR, Rd	B		2								CCR → Rd8	—	—	—	—	—	—	2	
STC CCR, @ERd	W			4							CCR → @ERd	—	—	—	—	—	—	6	
STC CCR, @(d:16, ERd)	W				6						CCR → @(d:16, ERd)	—	—	—	—	—	—	8	
STC CCR, @(d:24, ERd)	W				10						CCR → @(d:24, ERd)	—	—	—	—	—	—	12	
STC CCR, @–ERd	W					4					ERd32Ð2 → ERd32 CCR → @ERd	—	—	—	—	—	—	8	
STC CCR, @aa:16	W						6				CCR → @aa:16	—	—	—	—	—	—	8	
STC CCR, @aa:24	W						8				CCR → @aa:24	—	—	—	—	—	—	10	
ANDC #xx:8, CCR	B	2									CCR∧#xx:8 → CCR	↕	↕	↕	↕	↕	↕	2	
ORC #xx:8, CCR	B	2									CCR∨#xx:8 → CCR	↕	↕	↕	↕	↕	↕	2	
XORC #xx:8, CCR	B	2									CCR⊕#xx:8 → CCR	↕	↕	↕	↕	↕	↕	2	
NOP	—									2	PC ← PC+2	—	—	—	—	—	—	2	

8. Block transfer instructions

Mnemonic	Operand Size	Addressing Mode and Instruction Length (bytes)									Operation	Condition Code						No. of States*1	
		#xx	Rn	@ERn	@(d, ERn)	@–ERn/@ERn+	@aa	@(d, PC)	@@aa	|		I	H	N	Z	V	C	Normal	Advanced
EEPMOV. B	—									4	if R4L - 0 repeat @R5 → @R6 R5+1 → R5 R6+1 → R6 R4L–1 → R4L until R4L=0 else next;	—	—	—	—	—	—	8+ 4n*2	
EEPMOV. W	—									4	if R4 - 0 repeat @R5 → @R6 R5+1 → R5 R6+1 → R6 R4–1 → R4 until R4=0 else next;	—	—	—	—	—	—	8+ 4n*2	

Notes: 1. The number of states is the number of states required for execution when the instruction and its operands are located in on-chip memory. For other cases see section A.3, Number of States Required for Execution.

2. n is the value set in register R4L or R4.

(1) Set to 1 when a carry or borrow occurs at bit 11; otherwise cleared to 0.

(2) Set to 1 when a carry or borrow occurs at bit 27; otherwise cleared to 0.

(3) Retains its previous value when the result is zero; otherwise cleared to 0.

(4) Set to 1 when the adjustment produces a carry; otherwise retains its previous value.

(5) The number of states required for execution of an instruction that transfers data in synchronization with the E clock is variable.

(6) Set to 1 when the divisor is negative; otherwise cleared to 0.

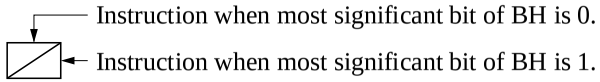
(7) Set to 1 when the divisor is zero; otherwise cleared to 0.

(8) Set to 1 when the quotient is negative; otherwise cleared to 0.

A.2 Operation Code Map (1)

Instruction code:

1st byte		2nd byte	
AH	AL	BH	BL



AH \ AL	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
0	NOP	Table A.2 (2)	STC	LDC	ORC	XORC	ANDC	LDC	ADD		Table A.2 (2)	Table A.2 (2)	MOV		ADDX	Table A.2 (2)
1	Table A.2 (2)	Table A.2 (2)	Table A.2 (2)	Table A.2 (2)	OR.B	XOR.B	AND.B	Table A.2 (2)	SUB		Table A.2 (2)	Table A.2 (2)	CMP		SUBX	Table A.2 (2)
2	MOV.B															
3																
4	BRA	BRN	BHI	BLS	BCC	BCS	BNE	BNQ	BVC	BVS	BPL	BMI	BGE	BLT	BGT	BLE
5	MULXU	DIVXU	MULXU	DIVXU	RTS	BSR	RTE	TRAPA	Table A.2 (2)	JMP			BSR	JSR		
6	BSET	BNOT	BCLR	BTST	OR	XOR	AND	BST / BIST	MOV							
7					BOR / BIOR	BXOR / BIXOR	BAND / BIAND	BLD / BILD	MOV	Table A.2 (2)	Table A.2 (2)	EEPMOV	Table A.2 (3)			
8	ADD															
9	ADDX															
A	CMP															
B	SUBX															
C	OR															
D	XOR															
E	AND															
F	MOV															

Instruction code:

1st byte		2nd byte	
AH	AL	BH	BL

AH AL \ BH	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
01	MOV				LDC/STC				SLEEP				Table A.2 (3)	Table A.2 (3)		Table A.2 (3)
0A	INC								ADD							
0B	ADDS					INC		INC	ADDS					INC		INC
0F	DAA								MOV							
10	SHLL			SHLL					SHAL			SHAL				
11	SHLR			SHLR					SHAR			SHAR				
12	ROTXL			ROTXL					ROTL			ROTL				
13	ROTXR			ROTXR					ROTR			ROTR				
17	NOT			NOT		EXTU		EXTU	NEG			NEG		EXTS		EXTS
1A	DEC								SUB							
1B	SUBS					DEC		DEC	SUBS					DEC		DEC
1F	DAS								CMP							
58	BRA	BRN	BHI	BLS	BCC	BCS	BNE	BEQ	BVC	BVS	BPL	BMI	BGE	BLT	BGT	BLE
79	MOV	ADD	CMP	SUB	OR	XOR	AND									
7A	MOV	ADD	CMP	SUB	OR	XOR	AND									

Instruction code:

1st byte		2nd byte		3rd byte		4th byte	
AH	AL	BH	BL	CH	CL	DH	DL

Instruction when most significant bit of DH is 0.

Instruction when most significant bit of DH is 1.

AH / ALBH / BLCH \ CL	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
01406										LDC / STC		LDC / STC		LDC / STC		LDC / STC
01C05	MULXS		MULXS													
01D05		DIVIXS		DIVXS												
01F06					OR	XOR	AND									
7Cr06 *1				BTST												
7Cr07 *1				BTST	BOR / BIOR	BXOR / BIXOR	BAND / BIAND	BLD / BILD								
7Dr06 *1	BSET	BNOT	BCLR					BST / BIST								
7Dr07 *1	BSET	BNOT	BCLR													
7Eaa6 *2				BTST												
7Eaa7 *2				BTST	BOR / BIOR	BXOR / BIXOR	BAND / BIAND	BLD / BILD								
7Faa6 *2	BSET	BNOT	BCLR					BST / BIST								
7Faa7 *2	BSET	BNOT	BCLR													

Notes: 1. r is the register designation field.
2. aa is the absolute address field.

A.3 Number of States Required for Execution

The tables in this section can be used to calculate the number of states required for instruction execution by the H8/300H CPU. Table A.4 indicates the number of instruction fetch, data read/write, and other cycles occurring in each instruction. Table A.3 indicates the number of states required per cycle according to the bus size. The number of states required for execution of an instruction can be calculated from these two tables as follows:

Number of states = $I \bullet S_I + J \bullet S_J + K \bullet S_K + L \bullet S_L + M \bullet S_M + N \bullet S_N$

Examples of Calculation of Number of States Required for Execution

Examples: Advanced mode, stack located in external address space, on-chip supporting modules accessed with 8-bit bus width, external devices accessed in three states with one wait state and 16-bit bus width.

BSET #0, @FFFFC7:8

From table A.4, I = L = 2 and J = K = M = N = 0
From table A.3, $S_I = 4$ and $S_L = 3$
Number of states = $2 \bullet 4 + 2 \bullet 3 = 14$

JSR @@30

From table A.4, I = J = K = 2 and L = M = N = 0
From table A.3, $S_I = S_J = S_K = 4$
Number of states = $2 \bullet 4 + 2 \bullet 4 + 2 \bullet 4 = 24$

Table A.3 Number of States per Cycle

		Access Conditions						
			On-Chip Supporting Module		External Device			
					8-Bit Bus		16-Bit Bus	
Execution State (Cycle)		**On-Chip Memory**	**8-Bit Bus**	**16-Bit Bus**	**2-State Access**	**3-State Access**	**2-State Access**	**3-State Access**
Instruction fetch	S_I	2	6	3	4	6 + 2m	2	3 + m
Branch address read	S_J							
Stack operation	S_K							
Byte data access	S_L		3		2	3 + m		
Word data access	S_M		6		4	6 + 2m		
Internal operation	S_N	1						

[Legend]

m: Number of wait states inserted into external device access

Table A.4 Number of Cycles per Instruction

Instruction	Mnemonic	Instruction Fetch I	Branch Addr. Read J	Stack Operation K	Byte Data Access L	Word Data Access M	Internal Operation N
ADD	ADD.B #xx:8, Rd	1					
	ADD.B Rs, Rd	1					
	ADD.W #xx:16, Rd	2					
	ADD.W Rs, Rd	1					
	ADD.L #xx:32, ERd	3					
	ADD.L ERs, ERd	1					
ADDS	ADDS #1/2/4, ERd	1					
ADDX	ADDX #xx:8, Rd	1					
	ADDX Rs, Rd	1					
AND	AND.B #xx:8, Rd	1					
	AND.B Rs, Rd	1					
	AND.W #xx:16, Rd	2					
	AND.W Rs, Rd	1					
	AND.L #xx:32, ERd	3					
	AND.L ERs, ERd	2					
ANDC	ANDC #xx:8, CCR	1					
BAND	BAND #xx:3, Rd	1					
	BAND #xx:3, @ERd	2			1		
	BAND #xx:3, @aa:8	2			1		
Bcc	BRA d:8 (BT d:8)	2					
	BRN d:8 (BF d:8)	2					
	BHI d:8	2					
	BLS d:8	2					
	BCC d:8 (BHS d:8)	2					
	BCS d:8 (BLO d:8)	2					
	BNE d:8	2					
	BEQ d:8	2					
	BVC d:8	2					
	BVS d:8	2					
	BPL d:8	2					
	BMI d:8	2					
	BGE d:8	2					
	BLT d:8	2					
	BGT d:8	2					
	BLE d:8	2					

Instruction	Mnemonic	Instruction Fetch I	Branch Addr. Read J	Stack Operation K	Byte Data Access L	Word Data Access M	Internal Operation N
Bcc	BRA d:16 (BT d:16)	2					2
	BRN d:16 (BF d:16)	2					2
	BHI d:16	2					2
	BLS d:16	2					2
	BCC d:16 (BHS d:16)	2					2
	BCS d:16 (BLO d:16)	2					2
	BNE d:16	2					2
	BEQ d:16	2					2
	BVC d:16	2					2
	BVS d:16	2					2
	BPL d:16	2					2
	BMI d:16	2					2
	BGE d:16	2					2
	BLT d:16	2					2
	BGT d:16	2					2
	BLE d:16	2					2
BCLR	BCLR #xx:3, Rd	1					
	BCLR #xx:3, @ERd	2			2		
	BCLR #xx:3, @aa:8	2			2		
	BCLR Rn, Rd	1					
	BCLR Rn, @ERd	2			2		
	BCLR Rn, @aa:8	2			2		
BIAND	BIAND #xx:3, Rd	1					
	BIAND #xx:3, @ERd	2			1		
	BIAND #xx:3, @aa:8	2			1		
BILD	BILD #xx:3, Rd	1					
	BILD #xx:3, @ERd	2			1		
	BILD #xx:3, @aa:8	2			1		
BIOR	BIOR #xx:8, Rd	1					
	BIOR #xx:8, @ERd	2			1		
	BIOR #xx:8, @aa:8	2			1		
BIST	BIST #xx:3, Rd	1					
	BIST #xx:3, @ERd	2			2		
	BIST #xx:3, @aa:8	2			2		
BIXOR	BIXOR #xx:3, Rd	1					
	BIXOR #xx:3, @ERd	2			1		
	BIXOR #xx:3, @aa:8	2			1		
BLD	BLD #xx:3, Rd	1					
	BLD #xx:3, @ERd	2			1		
	BLD #xx:3, @aa:8	2			1		

Instruction	Mnemonic		Instruction Fetch I	Branch Addr. Read J	Stack Operation K	Byte Data Access L	Word Data Access M	Internal Operation N
BNOT	BNOT #xx:3, Rd		1					
	BNOT #xx:3, @ERd		2			2		
	BNOT #xx:3, @aa:8		2			2		
	BNOT Rn, Rd		1					
	BNOT Rn, @ERd		2			2		
	BNOT Rn, @aa:8		2			2		
BOR	BOR #xx:3, Rd		1					
	BOR #xx:3, @ERd		2			1		
	BOR #xx:3, @aa:8		2			1		
BSET	BSET #xx:3, Rd		1					
	BSET #xx:3, @ERd		2			2		
	BSET #xx:3, @aa:8		2			2		
	BSET Rn, Rd		1					
	BSET Rn, @ERd		2			2		
	BSET Rn, @aa:8		2			2		
BSR	BSR d:8	Normal	2		1			
		Advanced	2		2			
	BSR d:16	Normal	2		1			2
		Advanced	2		2			2
BST	BST #xx:3, Rd		1					
	BST #xx:3, @ERd		2			2		
	BST #xx:3, @aa:8		2			2		
BTST	BTST #xx:3, Rd		1					
	BTST #xx:3, @ERd		2			1		
	BTST #xx:3, @aa:8		2			1		
	BTST Rn, Rd		1					
	BTST Rn, @ERd		2			1		
	BTST Rn, @aa:8		2			1		
BXOR	BXOR #xx:3, Rd		1					
	BXOR #xx:3, @ERd		2			1		
	BXOR #xx:3, @aa:8		2			1		
CMP	CMP.B #xx:8, Rd		1					
	CMP.B Rs, Rd		1					
	CMP.W #xx:16, Rd		2					
	CMP.W Rs, Rd		1					
	CMP.L #xx:32, ERd		3					
	CMP.L ERs, ERd		1					
DAA	DAA Rd		1					
DAS	DAS Rd		1					

Instruction	Mnemonic		Instruction Fetch I	Branch Addr. Read J	Stack Operation K	Byte Data Access L	Word Data Access M	Internal Operation N
DEC	DEC.B Rd		1					
	DEC.W #1/2, Rd		1					
	DEC.L #1/2, ERd		1					
DIVXS	DIVXS.B Rs, Rd		2					12
	DIVXS.W Rs, ERd		2					20
DIVXU	DIVXU.B Rs, Rd		1					12
	DIVXU.W Rs, ERd		1					20
EEPMOV	EEPMOV.B		2			2n + 2*[1]		
	EEPMOV.W		2			2n + 2*[1]		
EXTS	EXTS.W Rd		1					
	EXTS.L ERd		1					
EXTU	EXTU.W Rd		1					
	EXTU.L ERd		1					
INC	INC.B Rd		1					
	INC.W #1/2, Rd		1					
	INC.L #1/2, ERd		1					
JMP	JMP @ERn		2					
	JMP @aa:24		2					2
	JMP @@aa:8	Normal	2	1				2
		Advanced	2	2				2
JSR	JSR @ERn	Normal	2		1			
		Advanced	2		2			
	JSR @aa:24	Normal	2		1			2
		Advanced	2		2			2
	JSR @@aa:8	Normal	2	1	1			
		Advanced	2	2	2			
LDC	LDC #xx:8, CCR		1					
	LDC Rs, CCR		1					
	LDC @ERs, CCR		2				1	
	LDC @(d:16, ERs), CCR		3				1	
	LDC @(d:24, ERs), CCR		5				1	
	LDC @ERs+, CCR		2				1	2
	LDC @aa:16, CCR		3				1	
	LDC @aa:24, CCR		4				1	

Instruction	Mnemonic	Instruction Fetch I	Branch Addr. Read J	Stack Operation K	Byte Data Access L	Word Data Access M	Internal Operation N
MOV	MOV.B #xx:8, Rd	1					
	MOV.B Rs, Rd	1					
	MOV.B @ERs, Rd	1			1		
	MOV.B @(d:16, ERs), Rd	2			1		
	MOV.B @(d:24, ERs), Rd	4			1		
	MOV.B @ERs+, Rd	1			1		2
	MOV.B @aa:8, Rd	1			1		
	MOV.B @aa:16, Rd	2			1		
	MOV.B @aa:24, Rd	3			1		
	MOV.B Rs, @ERd	1			1		
	MOV.B Rs, @(d:16, ERd)	2			1		
	MOV.B Rs, @(d:24, ERd)	4			1		
	MOV.B Rs, @–ERd	1			1		2
	MOV.B Rs, @aa:8	1			1		
	MOV.B Rs, @aa:16	2			1		
	MOV.B Rs, @aa:24	3			1		
	MOV.W #xx:16, Rd	2					
	MOV.W Rs, Rd	1					
	MOV.W @ERs, Rd	1				1	
	MOV.W @(d:16, ERs), Rd	2				1	
	MOV.W @(d:24, ERs), Rd	4				1	
	MOV.W @ERs+, Rd	1				1	2
	MOV.W @aa:16, Rd	2				1	
	MOV.W @aa:24, Rd	3				1	
	MOV.W Rs, @ERd	1				1	
	MOV.W Rs, @(d:16, ERd)	2				1	
	MOV.W Rs, @(d:24, ERd)	4				1	
	MOV.W Rs, @–ERd	1				1	2
	MOV.W Rs, @aa:16	2				1	
	MOV.W Rs, @aa:24	3				1	
	MOV.L #xx:32, ERd	3					
	MOV.L ERs, ERd	1					
	MOV.L @ERs, ERd	2				2	
	MOV.L @(d:16, ERs), ERd	3				2	
	MOV.L @(d:24, ERs), ERd	5				2	
	MOV.L @ERs+, ERd	2				2	2
	MOV.L @aa:16, ERd	3				2	
	MOV.L @aa:24, ERd	4				2	
	MOV.L ERs, @ERd	2				2	
	MOV.L ERs, @(d:16, ERd)	3				2	
	MOV.L ERs, @(d:24, ERd)	5				2	
	MOV.L ERs, @–ERd	2				2	2
	MOV.L ERs, @aa:16	3				2	
	MOV.L ERs, @aa:24	4				2	

Instruction	Mnemonic	Instruction Fetch I	Branch Addr. Read J	Stack Operation K	Byte Data Access L	Word Data Access M	Internal Operation N
MOVFPE	MOVFPE @aa:16, Rd*[2]	2			1		
MOVTPE	MOVTPE Rs, @aa:16*[2]	2			1		
MULXS	MULXS.B Rs, Rd	2					12
	MULXS.W Rs, ERd	2					20
MULXU	MULXU.B Rs, Rd	1					12
	MULXU.W Rs, ERd	1					20
NEG	NEG.B Rd	1					
	NEG.W Rd	1					
	NEG.L ERd	1					
NOP	NOP	1					
NOT	NOT.B Rd	1					
	NOT.W Rd	1					
	NOT.L ERd	1					
OR	OR.B #xx:8, Rd	1					
	OR.B Rs, Rd	1					
	OR.W #xx:16, Rd	2					
	OR.W Rs, Rd	1					
	OR.L #xx:32, ERd	3					
	OR.L ERs, ERd	2					
ORC	ORC #xx:8, CCR	1					
POP	POP.W Rn	1				1	2
	POP.L ERn	2				2	2
PUSH	PUSH.W Rn	1				1	2
	PUSH.L ERn	2				2	2
ROTL	ROTL.B Rd	1					
	ROTL.W Rd	1					
	ROTL.L ERd	1					
ROTR	ROTR.B Rd	1					
	ROTR.W Rd	1					
	ROTR.L ERd	1					
ROTXL	ROTXL.B Rd	1					
	ROTXL.W Rd	1					
	ROTXL.L ERd	1					
ROTXR	ROTXR.B Rd	1					
	ROTXR.W Rd	1					
	ROTXR.L ERd	1					
RTE	RTE	2		2			2

Instruction	Mnemonic		Instruction Fetch I	Branch Addr. Read J	Stack Operation K	Byte Data Access L	Word Data Access M	Internal Operation N
RTS	RTS	Normal	2		1			2
		Advanced	2		2			2
SHAL	SHAL.B Rd		1					
	SHAL.W Rd		1					
	SHAL.L ERd		1					
SHAR	SHAR.B Rd		1					
	SHAR.W Rd		1					
	SHAR.L ERd		1					
SHLL	SHLL.B Rd		1					
	SHLL.W Rd		1					
	SHLL.L ERd		1					
SHLR	SHLR.B Rd		1					
	SHLR.W Rd		1					
	SHLR.L ERd		1					
SLEEP	SLEEP		1					
STC	STC CCR, Rd		1					
	STC CCR, @ERd		2				1	
	STC CCR, @(d:16, ERd)		3				1	
	STC CCR, @(d:24, ERd)		5				1	
	STC CCR, @–ERd		2				1	2
	STC CCR, @aa:16		3				1	
	STC CCR, @aa:24		4				1	
SUB	SUB.B Rs, Rd		1					
	SUB.W #xx:16, Rd		2					
	SUB.W Rs, Rd		1					
	SUB.L #xx:32, ERd		3					
	SUB.L ERs, ERd		1					
SUBS	SUBS #1/2/4, ERd		1					
SUBX	SUBX #xx:8, Rd		1					
	SUBX Rs, Rd		1					
TRAPA	TRAPA #x:2	Normal	2	1	2			4
		Advanced	2	2	2			4
XOR	XOR.B #xx:8, Rd		1					
	XOR.B Rs, Rd		1					
	XOR.W #xx:16, Rd		2					
	XOR.W Rs, Rd		1					
	XOR.L #xx:32, ERd		3					
	XOR.L ERs, ERd		2					
XORC	XORC #xx:8, CCR		1					

Notes: 1. n is the value set in register R4L or R4. The source and destination are accessed n + 1 times each.

2. Not available in the H8/3069R.

B.1 Addresses (EMC = 1)

Address (Low)	Register Name	Data Bus Width	Bit Names								Module Name
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
H'EE000	P1DDR	8	$P1_7DDR$	$P1_6DDR$	$P1_5DDR$	$P1_4DDR$	$P1_3DDR$	$P1_2DDR$	$P1_1DDR$	$P1_0DDR$	Port 1
H'EE001	P2DDR	8	$P2_7DDR$	$P2_6DDR$	$P2_5DDR$	$P2_4DDR$	$P2_3DDR$	$P2_2DDR$	$P2_1DDR$	$P2_0DDR$	Port 2
H'EE002	P3DDR	8	$P3_7DDR$	$P3_8DDR$	$P3_5DDR$	$P3_4DDR$	$P3_3DDR$	$P3_2DDR$	$P3_1DDR$	$P3_0DDR$	Port 3
H'EE003	P4DDR	8	$P4_7DDR$	$P4_6DDR$	$P4_5DDR$	$P4_4DDR$	$P4_3DDR$	$P4_2DDR$	$P4_1DDR$	$P4_0DDR$	Port 4
H'EE004	P5DDR	8	—	—	—	—	$P5_3DDR$	$P5_2DDR$	$P5_1DDR$	$P5_0DDR$	Port 5
H'EE005	P6DDR	8	—	$P6_8DDR$	$P6_8DDR$	$P6_4DDR$	$P6_3DDR$	$P6_2DDR$	$P6_1DDR$	$P6_0DDR$	Port 6
H'EE006	—		—	—	—	—	—	—	—	—	
H'EE007	P8DDR	8	—	—	—	$P8_4DDR$	$P8_3DDR$	$P8_2DDR$	$P8_1DDR$	$P8_0DDR$	Port 8
H'EE008	P9DDR	8	—	—	$P9_5DDR$	$P9_4DDR$	$P9_3DDR$	$P9_2DDR$	$P9_1DDR$	$P9_0DDR$	Port 9
H'EE009	PADDR	8	PA_7DDR	PA_6DDR	PA_5DDR	PA_4DDR	PA_3DDR	PA_2DDR	PA_1DDR	PA_0DDR	Port A
H'EE00A	PBDDR	8	PB_7DDR	PB_6DDR	PB_5DDR	PB_4DDR	PB_3DDR	PB_2DDR	PB_1DDR	PB_0DDR	Port B
H'EE00B	—		—	—	—	—	—	—	—	—	
H'EE00C	—		—	—	—	—	—	—	—	—	
H'EE00D	—		—	—	—	—	—	—	—	—	
H'EE00E	—		—	—	—	—	—	—	—	—	
H'EE00F	—		—	—	—	—	—	—	—	—	
H'EE010	—		—	—	—	—	—	—	—	—	
H'EE011	MDCR	8	—	—	—	—	—	MDS2	MDS1	MDS0	System control
H'EE012	SYSCR	8	SSBY	STS2	STS1	STS0	UE	NMIEG	SSOE	RAME	
H'EE013	BRCR	8	A23E	A22E	A21E	A20E	—	—	—	BRLE	Bus controller
H'EE014	ISCR	8	—	—	IRQ5SC	IRQ4SC	IRQ3SC	IRQ2SC	IRQ1SC	IRQ0SC	Interrupt controller
H'EE015	IER	8	—	—	IRQ5E	IRQ4E	IRQ3E	IRQ2E	IRQ1E	IRQ0E	
H'EE016	ISR	8	—	—	IRQ5F	IRQ4F	IRQ3F	IRQ2F	IRQ1F	IRQ0F	
H'EE017	—		—	—	—	—	—	—	—	—	
H'EE018	IPRA	8	IPRA7	IPRA6	IPRA5	IPRA4	IPRA3	IPRA2	IPRA1	IPRA0	
H'EE019	IPRB	8	IPRB7	IPRB6	IPRB5	—	IPRB3	IPRB2	IPRB1	—	
H'EE01A	DASTCR	8	—	—	—	—	—	—	—	DASTE	D/A converter
H'EE01B	DIVCR	8	—	—	—	—	—	—	DIV1	DIV0	System control
H'EE01C	MSTCRH	8	PSTOP	—	—	—	—	MSTPH2	MSTPH1	MSTPH0	
H'EE01D	MSTCRL	8	MSTPL7	—	MSTPL5	MSTPL4	MSTPL3	MSTPL2	—	MSTPL0	
H'EE01E	ADRCR	8	—	—	—	—	—	—	—	ADRCTL	Bus controller
H'EE01F	CSCR	8	CS7E	CS6E	CS5E	CS4E	—	—	—	—	

Address (Low)	Register Name	Data Bus Width	Bit Names								Module Name
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
H'EE020	ABWCR	8	ABW7	ABW6	ABW5	ABW4	ABW3	ABW2	ABW1	ABW0	Bus controller
H'EE021	ASTCR	8	AST7	AST6	AST5	AST4	AST3	AST2	AST1	AST0	
H'EE022	WCRH	8	W71	W70	W61	W60	W51	W50	W41	W40	
H'EE023	WCRL	8	W31	W30	W21	W20	W11	W10	W01	W00	
H'EE024	BCR	8	ICIS1	ICIS0	BROME	BRSTS1	BRSTS0	—	RDEA	WAITE	
H'EE025	—		—	—	—	—	—	—	—	—	
H'EE026	DRCRA	8	DRAS2	DRAS1	DRAS0	—	BE	RDM	SRFMD	RFSHE	DRAM Interface
H'EE027	DRCRB	8	MXC1	MXC0	CSEL	RCYCE	—	TPC	RCW	RLW	
H'EE028	RTMCSR	8	CMF	CMIE	CKS2	CKS1	CKS0	—	—	—	
H'EE029	RTCNT	8									
H'EE02A	RTCOR	8									
H'EE02B	—		—	—	—	—	—	—	—	—	
H'EE02C	—		—	—	—	—	—	—	—	—	
H'EE02D	—		—	—	—	—	—	—	—	—	
H'EE02E	—		—	—	—	—	—	—	—	—	
H'EE02F	—		—	—	—	—	—	—	—	—	
H'EE030	—		—	—	—	—	—	—	—	—	
H'EE031	—		—	—	—	—	—	—	—	—	
H'EE032	—		—	—	—	—	—	—	—	—	
H'EE033	—		—	—	—	—	—	—	—	—	
H'EE034	—		—	—	—	—	—	—	—	—	
H'EE035	—		—	—	—	—	—	—	—	—	
H'EE036	—		—	—	—	—	—	—	—	—	
H'EE037	—		—	—	—	—	—	—	—	—	
H'EE038	Reserved area (access prohibited)										
H'EE039											
H'EE03A											
H'EE03B											
H'EE03C	P2PCR	8	$P2_7PCR$	$P2_6PCR$	$P2_5PCR$	$P2_4PCR$	$P2_3PCR$	$P2_2PCR$	$P2_1PCR$	$P2_0PCR$	Port 2
H'EE03D	—		—	—	—	—	—	—	—	—	
H'EE03E	P4PCR	8	$P4_7PCR$	$P4_6PCR$	$P4_5PCR$	$P4_4PCR$	$P4_3PCR$	$P4_2PCR$	$P4_1PCR$	$P4_0PCR$	Port 4
H'EE03F	P5PCR	8	—	—	—	—	$P5_3PCR$	$P5_2PCR$	$P5_1PCR$	$P5_0PCR$	Port 5

Address (Low)	Register Name	Data Bus Width	Bit Names								Module Name
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
H'EE040	—		—	—	—	—	—	—	—	—	
H'EE041	—		—	—	—	—	—	—	—	—	
H'EE042	—		—	—	—	—	—	—	—	—	
H'EE043	—		—	—	—	—	—	—	—	—	
H'EE044	—		—	—	—	—	—	—	—	—	
H'EE045	—		—	—	—	—	—	—	—	—	
H'EE046	—		—	—	—	—	—	—	—	—	
H'EE047	—		—	—	—	—	—	—	—	—	
H'EE048	—		—	—	—	—	—	—	—	—	
H'EE049	—		—	—	—	—	—	—	—	—	
H'EE04A	—		—	—	—	—	—	—	—	—	
H'EE04B	—		—	—	—	—	—	—	—	—	
H'EE04C	—		—	—	—	—	—	—	—	—	
H'EE04D	—		—	—	—	—	—	—	—	—	
H'EE04E	—		—	—	—	—	—	—	—	—	
H'EE04F	—		—	—	—	—	—	—	—	—	
H'EE050	—		—	—	—	—	—	—	—	—	
H'EE051	—		—	—	—	—	—	—	—	—	
H'EE052	—		—	—	—	—	—	—	—	—	
H'EE053	—		—	—	—	—	—	—	—	—	
H'EE054	—		—	—	—	—	—	—	—	—	
H'EE055	—		—	—	—	—	—	—	—	—	
H'EE056	—		—	—	—	—	—	—	—	—	
H'EE057	—		—	—	—	—	—	—	—	—	
H'EE058	—		—	—	—	—	—	—	—	—	
H'EE059	—		—	—	—	—	—	—	—	—	
H'EE05A	—		—	—	—	—	—	—	—	—	
H'EE05B	—		—	—	—	—	—	—	—	—	
H'EE05C	—		—	—	—	—	—	—	—	—	
H'EE05D	—		—	—	—	—	—	—	—	—	
H'EE05E	—		—	—	—	—	—	—	—	—	
H'EE05F	—		—	—	—	—	—	—	—	—	

Address (Low)	Register Name	Data Bus Width	Bit Names								Module Name
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
H'EE060	—		—	—	—	—	—	—	—	—	
H'EE061	—		—	—	—	—	—	—	—	—	
H'EE062	—		—	—	—	—	—	—	—	—	
H'EE063	—		—	—	—	—	—	—	—	—	
H'EE064	—		—	—	—	—	—	—	—	—	
H'EE065	—		—	—	—	—	—	—	—	—	
H'EE066	—		—	—	—	—	—	—	—	—	
H'EE067	—		—	—	—	—	—	—	—	—	
H'EE068	—		—	—	—	—	—	—	—	—	
H'EE069	—		—	—	—	—	—	—	—	—	
H'EE06A	—		—	—	—	—	—	—	—	—	
H'EE06B	—		—	—	—	—	—	—	—	—	
H'EE06C	—		—	—	—	—	—	—	—	—	
H'EE06D	—		—	—	—	—	—	—	—	—	
H'EE06E	—		—	—	—	—	—	—	—	—	
H'EE06F	—		—	—	—	—	—	—	—	—	
H'EE070	—		—	—	—	—	—	—	—	—	
H'EE071	—		—	—	—	—	—	—	—	—	
H'EE072	—		—	—	—	—	—	—	—	—	
H'EE073	—		—	—	—	—	—	—	—	—	
H'EE074	Reserved area (access prohibited)										
H'EE075											
H'EE076											
H'EE077	RAMCR	8	—	—	—	—	RAMS	RAM2	RAM1	RAM0	Flash memory*
H'EE078	—		—	—	—	—	—	—	—	—	
H'EE079	—		—	—	—	—	—	—	—	—	
H'EE07A	—		—	—	—	—	—	—	—	—	
H'EE07B	—		—	—	—	—	—	—	—	—	
H'EE07C	—		—	—	—	—	—	—	—	—	
H'EE07D	—		—	—	—	—	—	—	—	—	
H'EE07E	—		—	—	—	—	—	—	—	—	
H'EE07F	—		—	—	—	—	—	—	—	—	

Address (Low)	Register Name	Data Bus Width	Bit Names								Module Name
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
H'EE080	—		—	—	—	—	—	—	—	—	
H'EE081	—		—	—	—	—	—	—	—	—	
H'EE082	—		—	—	—	—	—	—	—	—	
H'EE083	—		—	—	—	—	—	—	—	—	
H'EE084	—		—	—	—	—	—	—	—	—	
H'EE085	—		—	—	—	—	—	—	—	—	
H'EE086	—		—	—	—	—	—	—	—	—	
H'EE087	—		—	—	—	—	—	—	—	—	
H'EE088	—		—	—	—	—	—	—	—	—	
H'EE089	—		—	—	—	—	—	—	—	—	
H'EE08A	—		—	—	—	—	—	—	—	—	
H'EE08B	—		—	—	—	—	—	—	—	—	
H'EE08C	—		—	—	—	—	—	—	—	—	
H'EE08D	—		—	—	—	—	—	—	—	—	
H'EE08E	—		—	—	—	—	—	—	—	—	
H'EE08F	—		—	—	—	—	—	—	—	—	
H'EE090	—		—	—	—	—	—	—	—	—	
H'EE091	—		—	—	—	—	—	—	—	—	
H'EE092	—		—	—	—	—	—	—	—	—	
H'EE093	—		—	—	—	—	—	—	—	—	
H'EE094	—		—	—	—	—	—	—	—	—	
H'EE095	—		—	—	—	—	—	—	—	—	
H'EE096	—		—	—	—	—	—	—	—	—	
H'EE097	—		—	—	—	—	—	—	—	—	
H'EE098	—		—	—	—	—	—	—	—	—	
H'EE099	—		—	—	—	—	—	—	—	—	
H'EE09A	—		—	—	—	—	—	—	—	—	
H'EE09B	—		—	—	—	—	—	—	—	—	
H'EE09C	—		—	—	—	—	—	—	—	—	
H'EE09D	—		—	—	—	—	—	—	—	—	
H'EE09E	—		—	—	—	—	—	—	—	—	
H'EE09F	—		—	—	—	—	—	—	—	—	

Address (Low)	Register Name	Data Bus Width	Bit Names								Module Name
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
H'EE0A0	—		—	—	—	—	—	—	—	—	
H'EE0A1	—		—	—	—	—	—	—	—	—	
H'EE0A2	—		—	—	—	—	—	—	—	—	
H'EE0A3	—		—	—	—	—	—	—	—	—	
H'EE0A4	—		—	—	—	—	—	—	—	—	
H'EE0A5	—		—	—	—	—	—	—	—	—	
H'EE0A6	—		—	—	—	—	—	—	—	—	
H'EE0A7	—		—	—	—	—	—	—	—	—	
H'EE0A8	—		—	—	—	—	—	—	—	—	
H'EE0A9	—		—	—	—	—	—	—	—	—	
H'EE0AA	—		—	—	—	—	—	—	—	—	
H'EE0AB	—		—	—	—	—	—	—	—	—	
H'EE0AC	—		—	—	—	—	—	—	—	—	
H'EE0AD	—		—	—	—	—	—	—	—	—	
H'EE0AE	—		—	—	—	—	—	—	—	—	
H'EE0AF	—		—	—	—	—	—	—	—	—	
H'EE0B0	FCCS	8	FWE	—	—	FLER	—	—	—	SCO	Flash memory*
H'EE0B1	FPCS	8	—	—	—	—	—	—	—	PPVS	
H'EE0B2	FECS	8	—	—	—	—	—	—	—	EPVB	
H'EE0B3	Reserved area (access prohibited)										
H'EE0B4	FKEY	8	K7	K6	K5	K4	K3	K2	K1	K0	
H'EE0B5	FMATS	8	MS7	MS6	MS5	MS4	MS3	MS2	MS1	MS0	
H'EE0B6	FTDAR	8	TDER	TDA6	TDA5	TDA4	TDA3	TDA2	TDA1	TDA0	
H'EE0B7	FVACR	8	FVCHGE	—	—	—	FVSEL3	FVSEL2	FVSEL1	FVSEL0	
H'EE0B8	FVADRR	8									
H'EE0B9	FVADRE	8									
H'EE0BA	FVADRH	8									
H'EE0BB	FVADRL	8									
H'EE0BC	Reserved area (access prohibited)										
H'EE0BD	—		—	—	—	—	—	—	—	—	
H'EE0BE	—		—	—	—	—	—	—	—	—	
H'EE0BF	—		—	—	—	—	—	—	—	—	

Address (Low)	Register Name	Data Bus Width	Bit Names								Module Name
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
H'FFF20	MAR0AR	8									DMAC channel 0A
H'FFF21	MAR0AE	8									
H'FFF22	MAR0AH	8									
H'FFF23	MAR0AL	8									
H'FFF24	ETCR0AH	8									
H'FFF25	ETCR0AL	8									
H'FFF26	IOAR0A	8									
H'FFF27	DTCR0A	8	DTE	DTSZ	DTID	RPE	DTIE	DTS2	DTS1	DTS0	Short address mode
			DTE	DTSZ	SAID	SAIDE	DTIE	DTS2A	DTS1A	DTS0A	Full address mode
H'FFF28	MAR0BR	8									DMAC channel 0B
H'FFF29	MAR0BE	8									
H'FFF2A	MAR0BH	8									
H'FFF2B	MAR0BL	8									
H'FFF2C	ETCR0BH	8									
H'FFF2D	ETCR0BL	8									
H'FFF2E	IOAR0B	8									
H'FFF2F	DTCR0B	8	DTE	DTSZ	DTID	RPE	DTIE	DTS2	DTS1	DTS0	Short address mode
			DTME	—	DAID	DAIDE	TMS	DTS2B	DTS1B	DTS0B	Full address mode
H'FFF30	MAR1AR	8									DMAC channel 1A
H'FFF31	MAR1AE	8									
H'FFF32	MAR1AH	8									
H'FFF33	MAR1AL	8									
H'FFF34	ETCR1AH	8									
H'FFF35	ETCR1AL	8									
H'FFF36	IOAR1A	8									
H'FFF37	DTCR1A	8	DTE	DTSZ	DTID	RPE	DTIE	DTS2	DTS1	DTS0	Short address mode
			DTE	DTSZ	SAID	SAIDE	DTIE	DTS2A	DTS1A	DTS0A	Full address mode
H'FFF38	MAR1BR	8									DMAC channel 1B
H'FFF39	MAR1BE	8									
H'FFF3A	MAR1BH	8									
H'FFF3B	MAR1BL	8									
H'FFF3C	ETCR1BH	8									
H'FFF3D	ETCR1BL	8									
H'FFF3E	IOAR1B	8									
H'FFF3F	DTCR1B	8	DTE	DTSZ	DTID	RPE	DTIE	DTS2	DTS1	DTS0	Short address mode
			DTME	—	DAID	DAIDE	TMS	DTS2B	DTS1B	DTS0B	Full address mode

Address (Low)	Register Name	Data Bus Width	Bit Names								Module Name
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
H'FFF40	Reserved	area (access prohibited)									
H'FFF41											
H'FFF42											
H'FFF43											
H'FFF44											
H'FFF45											
H'FFF46											
H'FFF47											
H'FFF48											
H'FFF49											
H'FFF4A											
H'FFF4B											
H'FFF4C											
H'FFF4D											
H'FFF4E											
H'FFF4F											
H'FFF50	Reserved	area (access prohibited)									
H'FFF51											
H'FFF52											
H'FFF53											
H'FFF54											
H'FFF55											
H'FFF56											
H'FFF57											
H'FFF58											
H'FFF59											
H'FFF5A											
H'FFF5B											
H'FFF5C											
H'FFF5D											
H'FFF5E											
H'FFF5F											

Address (Low)	Register Name	Data Bus Width	Bit Names								Module Name
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
H'FFF60	TSTR	8	—	—	—	—	—	STR2	STR1	STR0	16-bit timer all channels
H'FFF61	TSNC	8	—	—	—	—	—	SYNC2	SYNC1	SYNC0	
H'FFF62	TMDR	8	—	MDF	FDIR	—	—	PWM2	PWM1	PWM0	
H'FFF63	TOLR	8	—	—	TOB2	TOA2	TOB1	TOA1	TOB0	TOA0	
H'FFF64	TISRA	8	—	IMIEA2	IMIEA1	IMIEA0	—	IMFA2	IMFA1	IMFA0	
H'FFF65	TISRB	8	—	IMIEB2	IMIEB1	IMIEB0	—	IMFB2	IMFB1	IMFB0	
H'FFF66	TISRC	8	—	OVIE2	OVIE1	OVIE0	—	OVF2	OVF1	OVF0	
H'FFF67	—		—	—	—	—	—	—	—	—	
H'FFF68	16TCR0	8	—	CCLR1	CCLR0	CKEG1	CKEG0	TPSC2	TPSC1	TPSC0	16-bit timer channel 0
H'FFF69	TIOR0	8	—	IOB2	IOB1	IOB0	—	IOA2	IOA1	IOA0	
H'FFF6A	16TCNT0H	16									
H'FFF6B	16TCNT0L										
H'FFF6C	GRA0H	16									
H'FFF6D	GRA0L										
H'FFF6E	GRB0H	16									
H'FFF6F	GRB0L										
H'FFF70	16TCR1	8	—	CCLR1	CCLR0	CKEG1	CKEG0	TPSC2	TPSC1	TPSC0	16-bit timer channel 1
H'FFF71	TIOR1	8	—	IOB2	IOB1	IOB0	—	IOA2	IOA1	IOA0	
H'FFF72	16TCNT1H	16									
H'FFF73	16TCNT1L										
H'FFF74	GRA1H	16									
H'FFF75	GRA1L										
H'FFF76	GRB1H	16									
H'FFF77	GRB1L										
H'FFF78	16TCR2	8	—	CCLR1	CCLR0	CKEG1	CKEG0	TPSC2	TPSC1	TPSC0	16-bit timer channel 2
H'FFF79	TIOR2	8	—	IOB2	IOB1	IOB0	—	IOA2	IOA1	IOA0	
H'FFF7A	16TCNT2H	16									
H'FFF7B	16TCNT2L										
H'FFF7C	GRA2H	16									
H'FFF7D	GRA2L										
H'FFF7E	GRB2H	16									
H'FFF7F	GRB2L										

Address (Low)	Register Name	Data Bus Width	Bit Names								Module Name
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
H'FFF80	8TCR0	8	CMIEB	CMIEA	OVIE	CCLR1	CCLR0	CKS2	CKS1	CKS0	8-bit timer channels 0 and 1
H'FFF81	8TCR1	8	CMIEB	CMIEA	OVIE	CCLR1	CCLR0	CKS2	CKS1	CKS0	
H'FFF82	8TCSR0	8	CMFB	CMFA	OVF	ADTE	OIS3	OIS2	OS1	OS0	
H'FFF83	8TCSR1	8	CMFB	CMFA	OVF	ICE	OIS3	OIS2	OS1	OS0	
H'FFF84	TCORA0	8									
H'FFF85	TCORA1	8									
H'FFF86	TCORB0	8									
H'FFF87	TCORB1	8									
H'FFF88	8TCNT0	8									
H'FFF89	8TCNT1	8									
H'FFF8A	—		—	—	—	—	—	—	—	—	
H'FFF8B	—		—	—	—	—	—	—	—	—	
H'FFF8C	TCSR*	8	OVF	WT/$\overline{\text{IT}}$	TME	—	—	CKS2	CKS1	CKS0	WDT
H'FFF8D	TCNT*	8									
H'FFF8E	—		—	—	—	—	—	—	—	—	
H'FFF8F	RSTCSR*	8	WRST	—	—	—	—	—	—	—	
H'FFF90	8TCR2	8	CMIEB	CMIEA	OVIE	CCLR1	CCLR0	CKS2	CKS1	CKS0	8-bit timer channels 2 and 3
H'FFF91	8TCR3	8	CMIEB	CMIEA	OVIE	CCLR1	CCLR0	CKS2	CKS1	CKS0	
H'FFF92	8TCSR2	8	CMFB	CMFA	OVF	—	OIS3	OIS2	OS1	OS0	
H'FFF93	8TCSR3	8	CMFB	CMFA	OVF	ICE	OIS3	OIS2	OS1	OS0	
H'FFF94	TCORA2	8									
H'FFF95	TCORA3	8									
H'FFF96	TCORB2	8									
H'FFF97	TCORB3	8									
H'FFF98	8TCNT2	8									
H'FFF99	8TCNT3	8									
H'FFF9A	—		—	—	—	—	—	—	—	—	
H'FFF9B	—		—	—	—	—	—	—	—	—	
H'FFF9C	DADR0	8									D/A converter
H'FFF9D	DADR1	8									
H'FFF9E	DACR	8	DAOE1	DAOE0	DAE	—	—	—	—	—	
H'FFF9F	—		—	—	—	—	—	—	—	—	

Address (Low)	Register Name	Data Bus Width	Bit Names								Module Name
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
H'FFFA0	TPMR	8	—	—	—	—	G3NOV	G2NOV	G1NOV	G0NOV	TPC
H'FFFA1	TPCR	8	G3CMS1	G3CMS0	G2CMS1	G2CMS0	G1CMS1	G1CMS0	G0CMS1	G0CMS0	
H'FFFA2	NDERB	8	NDER15	NDER14	NDER13	NDER12	NDER11	NDER10	NDER9	NDER8	
H'FFFA3	NDERA	8	NDER7	NDER6	NDER5	NDER4	NDER3	NDER2	NDER1	NDER0	
H'FFFA4	NDRB*	8	NDR15	NDR14	NDR13	NDR12	NDR11	NDR10	NDR9	NDR8	
			NDR15	NDR14	NDR13	NDR12	—	—	—	—	
H'FFFA5	NDRA*	8	NDR7	NDR6	NDR5	NDR4	NDR3	NDR2	NDR1	NDR0	
			NDR7	NDR6	NDR5	NDR4	—	—	—	—	
H'FFFA6	NDRB*	8	—	—	—	—	—	—	—	—	
			—	—	—	—	NDR11	NDR10	NDR9	NDR8	
H'FFFA7	NDRA*	8	—	—	—	—	—	—	—	—	
			—	—	—	—	NDR3	NDR2	NDR1	NDR0	
H'FFFA8	—		—	—	—	—	—	—	—	—	
H'FFFA9	—		—	—	—	—	—	—	—	—	
H'FFFAA	—		—	—	—	—	—	—	—	—	
H'FFFAB	—		—	—	—	—	—	—	—	—	
H'FFFAC	—		—	—	—	—	—	—	—	—	
H'FFFAD	—		—	—	—	—	—	—	—	—	
H'FFFAE	—		—	—	—	—	—	—	—	—	
H'FFFAF	—		—	—	—	—	—	—	—	—	
H'FFFB0	SMR	8	C/$\overline{A}$	CHR	PE	O/$\overline{E}$	STOP	MP	CKS1	CKS0	SCI channel 0
H'FFFB1	BRR	8									
H'FFFB2	SCR	8	TIE	RIE	TE	RE	MPIE	TEIE	CKE1	CKE0	
H'FFFB3	TDR	8									
H'FFFB4	SSR	8	TDRE	RDRF	ORER	FER/ERS	PER	TEND	MPB	MPBT	
H'FFFB5	RDR	8									
H'FFFB6	SCMR	8	—	—	—	—	SDIR	SINV	—	SMIF	
H'FFFB7	Reserved area (access prohibited)										
H'FFFB8	SMR	8	C/$\overline{A}$	CHR	PE	O/$\overline{E}$	STOP	MP	CKS1	CKS0	SCI channel 1
H'FFFB9	BRR	8									
H'FFFBA	SCR	8	TIE	RIE	TE	RE	MPIE	TEIE	CKE1	CKE0	
H'FFFBB	TDR	8									
H'FFFBC	SSR	8	TDRE	RDRF	ORER	FER/ERS	PER	TEND	MPB	MPBT	
H'FFFBD	RDR	8									
H'FFFBE	SCMR	8	—	—	—	—	SDIR	SINV	—	SMIF	
H'FFFBF	Reserved area (access prohibited)										

Address (Low)	Register Name	Data Bus Width	Bit Names								Module Name
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
H'FFFC0	SMR	8	C/$\overline{A}$	CHR	PE	O/$\overline{E}$	STOP	MP	CKS1	CKS0	SCI channel 2
H'FFFC1	BRR	8									
H'FFFC2	SCR	8	TIE	RIE	TE	RE	MPIE	TEIE	CKE1	CKE0	
H'FFFC3	TDR	8									
H'FFFC4	SSR	8	TDRE	RDRF	ORER	FER/ERS	PER	TEND	MPB	MPBT	
H'FFFC5	RDR	8									
H'FFFC6	SCMR	8	—	—	—	—	SDIR	SINV	—	SMIF	
H'FFFC7	Reserved area (access prohibited)										
H'FFFC8	—		—	—	—	—	—	—	—	—	
H'FFFC9	—		—	—	—	—	—	—	—	—	
H'FFFCA	—		—	—	—	—	—	—	—	—	
H'FFFCB	—		—	—	—	—	—	—	—	—	
H'FFFCC	—		—	—	—	—	—	—	—	—	
H'FFFCD	—		—	—	—	—	—	—	—	—	
H'FFFCE	—		—	—	—	—	—	—	—	—	
H'FFFCF	—		—	—	—	—	—	—	—	—	
H'FFFD0	P1DR	8	$P1_7$	$P1_6$	$P1_5$	$P1_4$	$P1_3$	$P1_2$	$P1_1$	$P1_0$	Port 1
H'FFFD1	P2DR	8	$P2_7$	$P2_6$	$P2_5$	$P2_4$	$P2_3$	$P2_2$	$P2_1$	$P2_0$	Port 2
H'FFFD2	P3DR	8	$P3_7$	$P3_6$	$P3_5$	$P3_4$	$P3_3$	$P3_2$	$P3_1$	$P3_0$	Port 3
H'FFFD3	P4DR	8	$P4_7$	$P4_6$	$P4_5$	$P4_4$	$P4_3$	$P4_2$	$P4_1$	$P4_0$	Port 4
H'FFFD4	P5DR	8	—	—	—	—	$P5_3$	$P5_2$	$P5_1$	$P5_0$	Port 5
H'FFFD5	P6DR	8	$P6_7$	$P6_6$	$P6_5$	$P6_4$	$P6_3$	$P6_2$	$P6_1$	$P6_0$	Port 6
H'FFFD6	P7DR	8	$P7_7$	$P7_6$	$P7_5$	$P7_4$	$P7_3$	$P7_2$	$P7_1$	$P7_0$	Port 7
H'FFFD7	P8DR	8	—	—	—	$P8_4$	$P8_3$	$P8_2$	$P8_1$	$P8_0$	Port 8
H'FFFD8	P9DR	8	—	—	$P9_5$	$P9_4$	$P9_3$	$P9_2$	$P9_1$	$P9_0$	Port 9
H'FFFD9	PADR	8	PA_7	PA_6	PA_5	PA_4	PA_3	PA_2	PA_1	PA_0	Port A
H'FFFDA	PBDR	8	PB_7	PB_6	PB_5	PB_4	PB_3	PB_2	PB_1	PB_0	Port B
H'FFFDB	—		—	—	—	—	—	—	—	—	
H'FFFDC	—		—	—	—	—	—	—	—	—	
H'FFFDD	—		—	—	—	—	—	—	—	—	
H'FFFDE	—		—	—	—	—	—	—	—	—	
H'FFFDF	—		—	—	—	—	—	—	—	—	

Address (Low)	Register Name	Data Bus Width	Bit Names								Module Name
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
H'FFFE0	ADDRAH	8	AD9	AD8	AD7	AD6	AD5	AD4	AD3	AD2	A/D converter
H'FFFE1	ADDRAL	8	AD1	AD0	—	—	—	—	—	—	
H'FFFE2	ADDRBH	8	AD9	AD8	AD7	AD6	AD5	AD4	AD3	AD2	
H'FFFE3	ADDRBL	8	AD1	AD0	—	—	—	—	—	—	
H'FFFE4	ADDRCH	8	AD9	AD8	AD7	AD6	AD5	AD4	AD3	AD2	
H'FFFE5	ADDRCL	8	AD1	AD0	—	—	—	—	—	—	
H'FFFE6	ADDRDH	8	AD9	AD8	AD7	AD6	AD5	AD4	AD3	AD2	
H'FFFE7	ADDRDL	8	AD1	AD0	—	—	—	—	—	—	
H'FFFE8	ADCSR	8	ADF	ADIE	ADST	SCAN	CKS	CH2	CH1	CH0	
H'FFFE9	ADCR	8	TRGE	—	—	—	—	—	—	—	

Note: * For write access to TCSR, TCNT, and RSTCSR, see section 12.2.4, Notes on Register Access. The address depends on the output trigger setting.

[Legend]

WDT: Watchdog timer

TPC: Programmable timing pattern controller

SCI: Serial communication interface

B.2 Addresses (EMC = 0)

Address (Low)	Register Name	Data Bus Width	Bit Names								Module Name
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
H'EE000	P1DDR	8	$P1_7$DDR	$P1_6$DDR	$P1_5$DDR	$P1_4$DDR	$P1_3$DDR	$P1_2$DDR	$P1_1$DDR	$P1_0$DDR	Port 1
H'EE001	P2DDR	8	$P2_7$DDR	$P2_6$DDR	$P2_5$DDR	$P2_4$DDR	$P2_3$DDR	$P2_2$DDR	$P2_1$DDR	$P2_0$DDR	Port 2
H'EE002	P3DDR	8	$P3_7$DDR	$P3_6$DDR	$P3_5$DDR	$P3_4$DDR	$P3_3$DDR	$P3_2$DDR	$P3_1$DDR	$P3_0$DDR	Port 3
H'EE003	P4DDR	8	$P4_7$DDR	$P4_6$DDR	$P4_5$DDR	$P4_4$DDR	$P4_3$DDR	$P4_2$DDR	$P4_1$DDR	$P4_0$DDR	Port 4
H'EE004	P5DDR	8	—	—	—	—	$P5_3$DDR	$P5_2$DDR	$P5_1$DDR	$P5_0$DDR	Port 5
H'EE005	P6DDR	8	—	$P6_6$DDR	$P6_5$DDR	$P6_4$DDR	$P6_3$DDR	$P6_2$DDR	$P6_1$DDR	$P6_0$DDR	Port 6
H'EE006	—		—	—	—	—	—	—	—	—	
H'EE007	P8DDR	8	—	—	—	$P8_4$DDR	$P8_3$DDR	$P8_2$DDR	$P8_1$DDR	$P8_0$DDR	Port 8
H'EE008	P9DDR	8	—	—	$P9_5$DDR	$P9_4$DDR	$P9_3$DDR	$P9_2$DDR	$P9_1$DDR	$P9_0$DDR	Port 9
H'EE009	PADDR	8	PA_7DDR	PA_6DDR	PA_5DDR	PA_4DDR	PA_3DDR	PA_2DDR	PA_1DDR	PA_0DDR	Port A
H'EE00A	PBDDR	8	PB_7DDR	PB_6DDR	PB_5DDR	PB_4DDR	PB_3DDR	PB_2DDR	PB_1DDR	PB_0DDR	Port B
H'EE00B	—		—	—	—	—	—	—	—	—	
H'EE00C	—		—	—	—	—	—	—	—	—	
H'EE00D	—		—	—	—	—	—	—	—	—	
H'EE00E	—		—	—	—	—	—	—	—	—	
H'EE00F	—		—	—	—	—	—	—	—	—	
H'EE010	—		—	—	—	—	—	—	—	—	
H'EE011	MDCR	8	—	—	—	—	—	MDS2	MDS1	MDS0	System control
H'EE012	SYSCR	8	SSBY	STS2	STS1	STS0	UE	NMIEG	SSOE	RAME	
H'EE013	BRCR	8	A23E	A22E	A21E	A20E	—	—	—	BRLE	Bus controller
H'EE014	ISCR	8	—	—	IRQ5SC	IRQ4SC	IRQ3SC	IRQ2SC	IRQ1SC	IRQ0SC	Interrupt controller
H'EE015	IER	8	—	—	IRQ5E	IRQ4E	IRQ3E	IRQ2E	IRQ1E	IRQ0E	
H'EE016	ISR	8	—	—	IRQ5F	IRQ4F	IRQ3F	IRQ2F	IRQ1F	IRQ0F	
H'EE017	—		—	—	—	—	—	—	—	—	
H'EE018	IPRA	8	IPRA7	IPRA6	IPRA5	IPRA4	IPRA3	IPRA2	IPRA1	IPRA0	
H'EE019	IPRB	8	IPRB7	IPRB6	IPRB5	—	IPRB3	IPRB2	IPRB1	—	
H'EE01A	DASTCR	8	—	—	—	—	—	—	—	DASTE	D/A converter
H'EE01B	DIVCR	8	—	—	—	—	—	—	DIV1	DIV0	System control
H'EE01C	MSTCRH	8	PSTOP	—	—	—	—	MSTPH2	MSTPH1	MSTPH0	
H'EE01D	MSTCRL	8	MSTPL7	—	MSTPL5	MSTPL4	MSTPL3	MSTPL2	—	MSTPL0	
H'EE01E	ADRCR	8	—	—	—	—	—	—	—	ADRCTL	Bus controller
H'EE01F	CSCR	8	CS7E	CS6E	CS5E	CS4E	—	—	—	—	

B.2 Addresses (cont)

Address (Low)	Register Name	Data Bus Width	Bit Names								Module Name
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
H'EE020	ABWCR	8	ABW7	ABW6	ABW5	ABW4	ABW3	ABW2	ABW1	ABW0	Bus controller
H'EE021	ASTCR	8	AST7	AST6	AST5	AST4	AST3	AST2	AST1	AST0	
H'EE022	WCRH	8	W71	W70	W61	W60	W51	W50	W41	W40	
H'EE023	WCRL	8	W31	W30	W21	W20	W11	W10	W01	W00	
H'EE024	BCR	8	ICIS1	ICIS0	BROME	BRSTS1	BRSTS0	—	RDEA	WAITE	
H'EE025	—		—	—	—	—	—	—	—	—	
H'EE026	DRCRA	8	DRAS2	DRAS1	DRAS0	—	BE	RDM	SRFMD	RFSHE	DRAM Interface
H'EE027	DRCRB	8	MXC1	MXC0	CSEL	RCYCE	—	TPC	RCW	RLW	
H'EE028	RTMCSR	8	CMF	CMIE	CKS2	CKS1	CKS0	—	—	—	
H'EE029	RTCNT	8									
H'EE02A	RTCOR	8									
H'EE02B	—		—	—	—	—	—	—	—	—	
H'EE02C	—		—	—	—	—	—	—	—	—	
H'EE02D	—		—	—	—	—	—	—	—	—	
H'EE02E	—		—	—	—	—	—	—	—	—	
H'EE02F	—		—	—	—	—	—	—	—	—	
H'EE030	—		—	—	—	—	—	—	—	—	
H'EE031	—		—	—	—	—	—	—	—	—	
H'EE032	—		—	—	—	—	—	—	—	—	
H'EE033	—		—	—							
H'EE034	—		—	—	—	—	—	—	—	—	
H'EE035	—		—	—	—	—	—	—	—	—	
H'EE036	—		—	—	—	—	—	—	—	—	
H'EE037	—		—	—	—	—	—	—	—	—	
H'EE038	Reserved area (access prohibited)										
H'EE039											
H'EE03A											
H'EE03B											
H'EE03C	P2PCR	8	$P2_7PCR$	$P2_6PCR$	$P2_5PCR$	$P2_4PCR$	$P2_3PCR$	$P2_2PCR$	$P2_1PCR$	$P2_0PCR$	Port 2
H'EE03D	—		—	—	—	—	—	—	—	—	
H'EE03E	P4PCR	8	$P4_7PCR$	$P4_6PCR$	$P4_5PCR$	$P4_4PCR$	$P4_3PCR$	$P4_2PCR$	$P4_1PCR$	$P4_0PCR$	Port 4
H'EE03F	P5PCR	8	—	—	—	—	$P5_3PCR$	$P5_2PCR$	$P5_1PCR$	$P5_0PCR$	Port 5

B.2 Addresses (cont)

Address (Low)	Register Name	Data Bus Width	Bit Names								Module Name
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
H'EE040	—		—	—	—	—	—	—	—	—	
H'EE041	—		—	—	—	—	—	—	—	—	
H'EE042	—		—	—	—	—	—	—	—	—	
H'EE043	—		—	—	—	—	—	—	—	—	
H'EE044	—		—	—	—	—	—	—	—	—	
H'EE045	—		—	—	—	—	—	—	—	—	
H'EE046	—		—	—	—	—	—	—	—	—	
H'EE047	—		—	—	—	—	—	—	—	—	
H'EE048	—		—	—	—	—	—	—	—	—	
H'EE049	—		—	—	—	—	—	—	—	—	
H'EE04A	—		—	—	—	—	—	—	—	—	
H'EE04B	—		—	—	—	—	—	—	—	—	
H'EE04C	—		—	—	—	—	—	—	—	—	
H'EE04D	—		—	—	—	—	—	—	—	—	
H'EE04E	—		—	—	—	—	—	—	—	—	
H'EE04F	—		—	—	—	—	—	—	—	—	
H'EE050	—		—	—	—	—	—	—	—	—	
H'EE051	—		—	—	—	—	—	—	—	—	
H'EE052	—		—	—	—	—	—	—	—	—	
H'EE053	—		—	—	—	—	—	—	—	—	
H'EE054	—		—	—	—	—	—	—	—	—	
H'EE055	—		—	—	—	—	—	—	—	—	
H'EE056	—		—	—	—	—	—	—	—	—	
H'EE057	—		—	—	—	—	—	—	—	—	
H'EE058	—		—	—	—	—	—	—	—	—	
H'EE059	—		—	—	—	—	—	—	—	—	
H'EE05A	—		—	—	—	—	—	—	—	—	
H'EE05B	—		—	—	—	—	—	—	—	—	
H'EE05C	—		—	—	—	—	—	—	—	—	
H'EE05D	—		—	—	—	—	—	—	—	—	
H'EE05E	—		—	—	—	—	—	—	—	—	
H'EE05F	—		—	—	—	—	—	—	—	—	

Address (Low)	Register Name	Data Bus Width	Bit Names								Module Name
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
H'EE060	—		—	—	—	—	—	—	—	—	
H'EE061	—		—	—	—	—	—	—	—	—	
H'EE062	—		—	—	—	—	—	—	—	—	
H'EE063	—		—	—	—	—	—	—	—	—	
H'EE064	—		—	—	—	—	—	—	—	—	
H'EE065	—		—	—	—	—	—	—	—	—	
H'EE066	—		—	—	—	—	—	—	—	—	
H'EE067	—		—	—	—	—	—	—	—	—	
H'EE068	—		—	—	—	—	—	—	—	—	
H'EE069	—		—	—	—	—	—	—	—	—	
H'EE06A	—		—	—	—	—	—	—	—	—	
H'EE06B	—		—	—	—	—	—	—	—	—	
H'EE06C	—		—	—	—	—	—	—	—	—	
H'EE06D	—		—	—	—	—	—	—	—	—	
H'EE06E	—		—	—	—	—	—	—	—	—	
H'EE06F	—		—	—	—	—	—	—	—	—	
H'EE070	—		—	—	—	—	—	—	—	—	
H'EE071	—		—	—	—	—	—	—	—	—	
H'EE072	—		—	—	—	—	—	—	—	—	
H'EE073	—		—	—	—	—	—	—	—	—	
H'EE074	Reserved area (access prohibited)										
H'EE075											
H'EE076											
H'EE077	RAMCR	8	—	—	—	—	RAMS	RAM2	RAM1	—	Flash memory*
H'EE078	—		—	—	—	—	—	—	—	—	
H'EE079	—		—	—	—	—	—	—	—	—	
H'EE07A	—		—	—	—	—	—	—	—	—	
H'EE07B	—		—	—	—	—	—	—	—	—	
H'EE07C	—		—	—	—	—	—	—	—	—	
H'EE07D	—		—	—	—	—	—	—	—	—	
H'EE07E	—		—	—	—	—	—	—	—	—	
H'EE07F	—		—	—	—	—	—	—	—	—	

B.2 Addresses (cont)

Address (Low)	Register Name	Data Bus Width	Bit Names								Module Name
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
H'EE080	—		—	—	—	—	—	—	—	—	
H'EE081	—		—	—	—	—	—	—	—	—	
H'EE082	—		—	—	—	—	—	—	—	—	
H'EE083	—		—	—	—	—	—	—	—	—	
H'EE084	—		—	—	—	—	—	—	—	—	
H'EE085	—		—	—	—	—	—	—	—	—	
H'EE086	—		—	—	—	—	—	—	—	—	
H'EE087	—		—	—	—	—	—	—	—	—	
H'EE088	—		—	—	—	—	—	—	—	—	
H'EE089	—		—	—	—	—	—	—	—	—	
H'EE08A	—		—	—	—	—	—	—	—	—	
H'EE08B	—		—	—	—	—	—	—	—	—	
H'EE08C	—		—	—	—	—	—	—	—	—	
H'EE08D	—		—	—	—	—	—	—	—	—	
H'EE08E	—		—	—	—	—	—	—	—	—	
H'EE08F	—		—	—	—	—	—	—	—	—	
H'EE090	TCSR*	8	OVF	WT/$\overline{IT}$	TME	—	—	CKS2	CKS1	CKS0	WDT
H'EE091	TCNT*	8									
H'EE092	—		—	—	—	—	—	—	—	—	
H'EE093	RSTCSR*	8	WRST	—	—	—	—	—	—	—	
H'EE094	—		—	—	—	—	—	—	—	—	
H'EE095	—		—	—	—	—	—	—	—	—	
H'EE096	—		—	—	—	—	—	—	—	—	
H'EE097	—		—	—	—	—	—	—	—	—	
H'EE098	—		—	—	—	—	—	—	—	—	
H'EE099	—		—	—	—	—	—	—	—	—	
H'EE09A	—		—	—	—	—	—	—	—	—	
H'EE09B	—		—	—	—	—	—	—	—	—	
H'EE09C	—		—	—	—	—	—	—	—	—	
H'EE09D	—		—	—	—	—	—	—	—	—	
H'EE09E	—		—	—	—	—	—	—	—	—	
H'EE09F	—		—	—	—	—	—	—	—	—	

B.2 Addresses (cont)

Address (Low)	Register Name	Data Bus Width	Bit Names								Module Name
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
H'EE0A0	—		—	—	—	—	—	—	—	—	
H'EE0A1	—		—	—	—	—	—	—	—	—	
H'EE0A2	—		—	—	—	—	—	—	—	—	
H'EE0A3	—		—	—	—	—	—	—	—	—	
H'EE0A4	—		—	—	—	—	—	—	—	—	
H'EE0A5	—		—	—	—	—	—	—	—	—	
H'EE0A6	—		—	—	—	—	—	—	—	—	
H'EE0A7	—		—	—	—	—	—	—	—	—	
H'EE0A8	—		—	—	—	—	—	—	—	—	
H'EE0A9	—		—	—	—	—	—	—	—	—	
H'EE0AA	—		—	—	—	—	—	—	—	—	
H'EE0AB	—		—	—	—	—	—	—	—	—	
H'EE0AC	—		—	—	—	—	—	—	—	—	
H'EE0AD	—		—	—	—	—	—	—	—	—	
H'EE0AE	—		—	—	—	—	—	—	—	—	
H'EE0AF	—		—	—	—	—	—	—	—	—	
H'EE0B0	FCCS	8	FWE	—	—	FLER	—	—	—	SCO	Flash memory*
H'EE0B1	FPCS	8	—	—	—	—	—	—	—	PPVS	
H'EE0B2	FECS	8	—	—	—	—	—	—	—	EPVB	
H'EE0B3	Reserved area (access prohibited)										
H'EE0B4	FKEY	8	K7	K6	K5	K4	K3	K2	K1	K0	
H'EE0B5	FMATS	8	MS7	MS6	MS5	MS4	MS3	MS2	MS1	MS0	
H'EE0B6	FTDAR	8	TDER	TDA6	TDA5	TDA4	TDA3	TDA2	TDA1	TDA0	
H'EE0B7	FVACR	8	FVCHGE	—	—	—	FVSEL3	FVSEL2	FVSEL1	FVSEL0	
H'EE0B8	FVADRR	8									
H'EE0B9	FVADRE	8									
H'EE0BA	FVADRH	8									
H'EE0BB	FVADRL	8									
H'EE0BC	Reserved area (access prohibited)										
H'EE0BD	—		—	—	—	—	—	—	—	—	
H'EE0BE	—		—	—	—	—	—	—	—	—	
H'EE0BF	—		—	—	—	—	—	—	—	—	

B.2 Addresses (cont)

Address (Low)	Register Name	Data Bus Width	Bit Names								Module Name
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
H'FFE80	MAR0AR	8									DMAC channel 0A
H'FFE81	MAR0AE	8									
H'FFE82	MAR0AH	8									
H'FFE83	MAR0AL	8									
H'FFE84	ETCR0AH	8									
H'FFE85	ETCR0AL	8									
H'FFE86	IOAR0A	8									
H'FFE87	DTCR0A	8	DTE	DTSZ	DTID	RPE	DTIE	DTS2	DTS1	DTS0	Short address mode
			DTE	DTSZ	SAID	SAIDE	DTIE	DTS2A	DTS1A	DTS0A	Full address mode
H'FFE88	MAR0BR	8									DMAC channel 0B
H'FFE89	MAR0BE	8									
H'FFE8A	MAR0BH	8									
H'FFE8B	MAR0BL	8									
H'FFE8C	ETCR0BH	8									
H'FFE8D	ETCR0BL	8									
H'FFE8E	IOAR0B	8									
H'FFE8F	DTCR0B	8	DTE	DTSZ	DTID	RPE	DTIE	DTS2	DTS1	DTS0	Short address mode
			DTME	—	DAID	DAIDE	TMS	DTS2B	DTS1B	DTS0B	Full address mode

B.2 Addresses (cont)

Address (Low)	Register Name	Data Bus Width	Bit Names								Module Name
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
H'FFE90	MAR1AR	8									DMAC channel 1A
H'FFE91	MAR1AE	8									
H'FFE92	MAR1AH	8									
H'FFE93	MAR1AL	8									
H'FFE94	ETCR1AH	8									
H'FFE95	ETCR1AL	8									
H'FFE96	IOAR1A	8									
H'FFE97	DTCR1A	8	DTE	DTSZ	DTID	RPE	DTIE	DTS2	DTS1	DTS0	Short address mode
			DTE	DTSZ	SAID	SAIDE	DTIE	DTS2A	DTS1A	DTS0A	Full address mode
H'FFE98	MAR1BR	8									DMAC channel 1B
H'FFE99	MAR1BE	8									
H'FFE9A	MAR1BH	8									
H'FFE9B	MAR1BL	8									
H'FFE9C	ETCR1BH	8									
H'FFE9D	ETCR1BL	8									
H'FFE9E	IOAR1B	8									
H'FFE9F	DTCR1B	8	DTE	DTSZ	DTID	RPE	DTIE	DTS2	DTS1	DTS0	Short address mode
			DTME	—	DAID	DAIDE	TMS	DTS2B	DTS1B	DTS0B	Full address mode

B.2 Addresses (cont)

Address (Low)	Register Name	Data Bus Width	Bit Names								Module Name
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
H'FFEA0	TSTR	8	—	—	—	—	—	STR2	STR1	STR0	16-bit timer, (all channels)
H'FFEA1	TSNC	8	—	—	—	—	—	SYNC2	SYNC1	SYNC0	
H'FFEA2	TMDR	8	—	MDF	FDIR	—	—	PWM2	PWM1	PWM0	
H'FFEA3	TOLR	8	—	—	TOB2	TOA2	TOB1	TOA1	TOB0	TOA0	
H'FFEA4	TISRA	8	—	IMIEA2	IMIEA1	IMIEA0	—	IMFA2	IMFA1	IMFA0	
H'FFEA5	TISRB	8	—	IMIEB2	IMIEB1	IMIEB0	—	IMFB2	IMFB1	IMFB0	
H'FFEA6	TISRC	8	—	OVIE2	OVIE1	OVIE0	—	OVF2	OVF1	OVF0	
H'FFEA7	—		—	—	—	—	—	—	—	—	
H'FFEA8	TCR0	8	—	CCLR1	CCLR0	CKEG1	CKEG0	TPSC2	TPSC1	TPSC0	16-bit timer channel 0
H'FFEA9	TIOR0	8	—	IOB2	IOB1	IOB0	—	IOA2	IOA1	IOA0	
H'FFEAA	16TCNT0H	16									
H'FFEAB	16TCNT0L										
H'FFEAC	GRA0H	16									
H'FFEAD	GRA0L										
H'FFEAE	GRB0H	16									
H'FFEAF	GRB0L										
H'FFEB0	TCR1	8	—	CCLR1	CCLR0	CKEG1	CKEG0	TPSC2	TPSC1	TPSC0	16-bit timer channel 1
H'FFEB1	TIOR1	8	—	IOB2	IOB1	IOB0	—	IOA2	IOA1	IOA0	
H'FFEB2	16TCNT1H	16									
H'FFEB3	16TCNT1L										
H'FFEB4	GRA1H	16									
H'FFEB5	GRA1L										
H'FFEB6	GRB1H	16									
H'FFEB7	GRB1L										
H'FFEB8	TCR2	8	—	CCLR1	CCLR0	CKEG1	CKEG0	TPSC2	TPSC1	TPSC0	16-bit timer channel 2
H'FFEB9	TIOR2	8	—	IOB2	IOB1	IOB0	—	IOA2	IOA1	IOA0	
H'FFEBA	16TCNT2H	16									
H'FFEBB	16TCNT2L										
H'FFEBC	GRA2H	16									
H'FFEBD	GRA2L										
H'FFEBE	GRB2H	16									
H'FFEBF	GRB2L										

B.2 Addresses (cont)

Address (Low)	Register Name	Data Bus Width	Bit Names								Module Name
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
H'FFEC0	8TCR0	8	CMIEB	CMIEA	OVIE	CCLR1	CCLR0	CKS2	CKS1	CKS0	8-bit timer channels 0 and 1
H'FFEC1	8TCR1	8	CMIEB	CMIEA	OVIE	CCLR1	CCLR0	CKS2	CKS1	CKS0	
H'FFEC2	8TCSR0	8	CMFB	CMFA	OVF	ADTE	OIS3	OIS2	OS1	OS0	
H'FFEC3	8TCSR1	8	CMFB	CMFA	OVF	ICE	OIS3	OIS2	OS1	OS0	
H'FFEC4	TCORA0	8									
H'FFEC5	TCORA1	8									
H'FFEC6	TCORB0	8									
H'FFEC7	TCORB1	8									
H'FFEC8	8TCNT0	8									
H'FFEC9	8TCNT1	8									
H'FFECA	—		—	—	—	—	—	—	—	—	
H'FFECB	—		—	—	—	—	—	—	—	—	
H'FFECC	—		—	—	—	—	—	—	—	—	
H'FFECD	—		—	—	—	—	—	—	—	—	
H'FFECE	—		—	—	—	—	—	—	—	—	
H'FFECF	—		—	—	—	—	—	—	—	—	
H'FFED0	8TCR2	8	CMIEB	CMIEA	OVIE	CCLR1	CCLR0	CKS2	CKS1	CKS0	8-bit timer channels 2 and 3
H'FFED1	8TCR3	8	CMIEB	CMIEA	OVIE	CCLR1	CCLR0	CKS2	CKS1	CKS0	
H'FFED2	8TCSR2	8	CMFB	CMFA	OVF	—	OIS3	OIS2	OS1	OS0	
H'FFED3	8TCSR3	8	CMFB	CMFA	OVF	ICE	OIS3	OIS2	OS1	OS0	
H'FFED4	TCORA2	8									
H'FFED5	TCORA3	8									
H'FFED6	TCORB2	8									
H'FFED7	TCORB3	8									
H'FFED8	8TCNT2	8									
H'FFED9	8TCNT3	8									
H'FFEDA	—		—	—	—	—	—	—	—	—	
H'FFEDB	—		—	—	—	—	—	—	—	—	
H'FFEDC	—		—	—	—	—	—	—	—	—	
H'FFEDD	—		—	—	—	—	—	—	—	—	
H'FFEDE	—		—	—	—	—	—	—	—	—	
H'FFEDF	—		—	—	—	—	—	—	—	—	

B.2 Addresses (cont)

Address (Low)	Register Name	Data Bus Width	Bit Names								Module Name
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
H'FFEE0	SMR	8	C/$\overline{A}$	CHR	PE	O/$\overline{E}$	STOP	MP	CKS1	CKS0	SCI channel 0
H'FFEE1	BRR	8									
H'FFEE2	SCR	8	TIE	RIE	TE	RE	MPIE	TEIE	CKE1	CKE0	
H'FFEE3	TDR	8									
H'FFEE4	SSR	8	TDRE	RDRF	ORER	FER/ERS	PER	TEND	MPB	MPBT	
H'FFEE5	RDR	8									
H'FFEE6	SCMR	8	—	—	—	—	SDIR	SINV	—	SMIF	
H'FFEE7	Reserved area (access prohibited)										
H'FFEE8	SMR	8	C/$\overline{A}$	CHR	PE	O/$\overline{E}$	STOP	MP	CKS1	CKS0	SCI channel 1
H'FFEE9	BRR	8									
H'FFEEA	SCR	8	TIE	RIE	TE	RE	MPIE	TEIE	CKE1	CKE0	
H'FFEEB	TDR	8									
H'FFEEC	SSR	8	TDRE	RDRF	ORER	FER/ERS	PER	TEND	MPB	MPBT	
H'FFEED	RDR	8									
H'FFEEE	SCMR	8	—	—	—	—	SDIR	SINV	—	SMIF	
H'FFEEF	Reserved area (access prohibited)										
H'FFEF0	SMR	8	C/$\overline{A}$	CHR	PE	O/$\overline{E}$	STOP	MP	CKS1	CKS0	SCI channel 2
H'FFEF1	BRR	8									
H'FFEF2	SCR	8	TIE	RIE	TE	RE	MPIE	TEIE	CKE1	CKE0	
H'FFEF3	TDR	8									
H'FFEF4	SSR	8	TDRE	RDRF	ORER	FER/ERS	PER	TEND	MPB	MPBT	
H'FFEF5	RDR	8									
H'FFEF6	SCMR	8	—	—	—	—	SDIR	SINV	—	SMIF	
H'FFEF7	Reserved area (access prohibited)										
H'FFEF8	TPMR	8	—	—	—	—	G3NOV	G2NOV	G1NOV	G0NOV	TPC
H'FFEF9	TPCR	8	G3CMS1	G3CMS0	G2CMS1	G2CMS0	G1CMS1	G1CMS0	G0CMS1	G0CMS0	
H'FFEFA	NDERB	8	NDER15	NDER14	NDER13	NDER12	NDER11	NDER10	NDER9	NDER8	
H'FFEFB	NDERA	8	NDER7	NDER6	NDER5	NDER4	NDER3	NDER2	NDER1	NDER0	
H'FFEFC	NDRB*	8	NDR15	NDR14	NDR13	NDR12	NDR11	NDR10	NDR9	NDR8	
			NDR15	NDR14	NDR13	NDR12	—	—	—	—	
H'FFEFD	NDRA*	8	NDR7	NDR6	NDR5	NDR4	NDR3	NDR2	NDR1	NDR0	
			NDR7	NDR6	NDR5	NDR4	—	—	—	—	
H'FFEFE	NDRB*	8	—	—	—	—	—	—	—	—	
			—	—	—	—	NDR11	NDR10	NDR9	NDR8	
H'FFEFF	NDRA*	8	—	—	—	—	—	—	—	—	
			—	—	—	—	NDR3	NDR2	NDR1	NDR0	

B.2 Addresses (cont)

Address (Low)	Register Name	Data Bus Width	Bit Names								Module Name
			Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
H'FFFE0	ADDRAH	8	AD9	AD8	AD7	AD6	AD5	AD4	AD3	AD2	A/D converter
H'FFFE1	ADDRAL	8	AD1	AD0	—	—	—	—	—	—	
H'FFFE2	ADDRBH	8	AD9	AD8	AD7	AD6	AD5	AD4	AD3	AD2	
H'FFFE3	ADDRBL	8	AD1	AD0	—	—	—	—	—	—	
H'FFFE4	ADDRCH	8	AD9	AD8	AD7	AD6	AD5	AD4	AD3	AD2	
H'FFFE5	ADDRCL	8	AD1	AD0	—	—	—	—	—	—	
H'FFFE6	ADDRDH	8	AD9	AD8	AD7	AD6	AD5	AD4	AD3	AD2	
H'FFFE7	ADDRDL	8	AD1	AD0	—	—	—	—	—	—	
H'FFFE8	ADCSR	8	ADF	ADIE	ADST	SCAN	CKS	CH2	CH1	CH0	
H'FFFE9	ADCR	8	TRGE	—	—	—	—	—	—	—	
H'FFFEA	—		—	—	—	—	—	—	—	—	
H'FFFEB	—		—	—	—	—	—	—	—	—	
H'FFFEC	DADR0	8									D/A converter
H'FFFED	DADR1	8									
H'FFFEE	DACR	8	DAOE1	DAOE0	DAE	—	—	—	—	—	
H'FFFEF	—		—	—	—	—	—	—	—	—	
H'FFFF0	P1DR	8	$P1_7$	$P1_6$	$P1_5$	$P1_4$	$P1_3$	$P1_2$	$P1_1$	$P1_0$	Port 1
H'FFFF1	P2DR	8	$P2_7$	$P2_6$	$P2_5$	$P2_4$	$P2_3$	$P2_2$	$P2_1$	$P2_0$	Port 2
H'FFFF2	P3DR	8	$P3_7$	$P3_6$	$P3_5$	$P3_4$	$P3_3$	$P3_2$	$P3_1$	$P3_0$	Port 3
H'FFFF3	P4DR	8	$P4_7$	$P4_6$	$P4_5$	$P4_4$	$P4_3$	$P4_2$	$P4_1$	$P4_0$	Port 4
H'FFFF4	P5DR	8	—	—	—	—	$P5_3$	$P5_2$	$P5_1$	$P5_0$	Port 5
H'FFFF5	P6DR	8	$P6_7$	$P6_6$	$P6_5$	$P6_4$	$P6_3$	$P6_2$	$P6_1$	$P6_0$	Port 6
H'FFFF6	P7DR	8	$P7_7$	$P7_6$	$P7_5$	$P7_4$	$P7_3$	$P7_2$	$P7_1$	$P7_0$	Port 7
H'FFFF7	P8DR	8	—	—	—	$P8_4$	$P8_3$	$P8_2$	$P8_1$	$P8_0$	Port 8
H'FFFF8	P9DR	8	—	—	$P9_5$	$P9_4$	$P9_3$	$P9_2$	$P9_1$	$P9_0$	Port 9
H'FFFF9	PADR	8	PA_7	PA_6	PA_5	PA_4	PA_3	PA_2	PA_1	PA_0	Port A
H'FFFFA	PBDR	8	PB_7	PB_6	PB_5	PB_4	PB_3	PB_2	PB_1	PB_0	Port B
H'FFFFB	—		—	—	—	—	—	—	—	—	
H'FFFFC	—		—	—	—	—	—	—	—	—	
H'FFFFD	—		—	—	—	—	—	—	—	—	
H'FFFFE	—		—	—	—	—	—	—	—	—	
H'FFFFF	—		—	—	—	—	—	—	—	—	

Note: * For write access to TCSR, TCNT, and RSTCSR, see section 12.2.4, Notes on Register Access. The address depends on the output trigger setting.

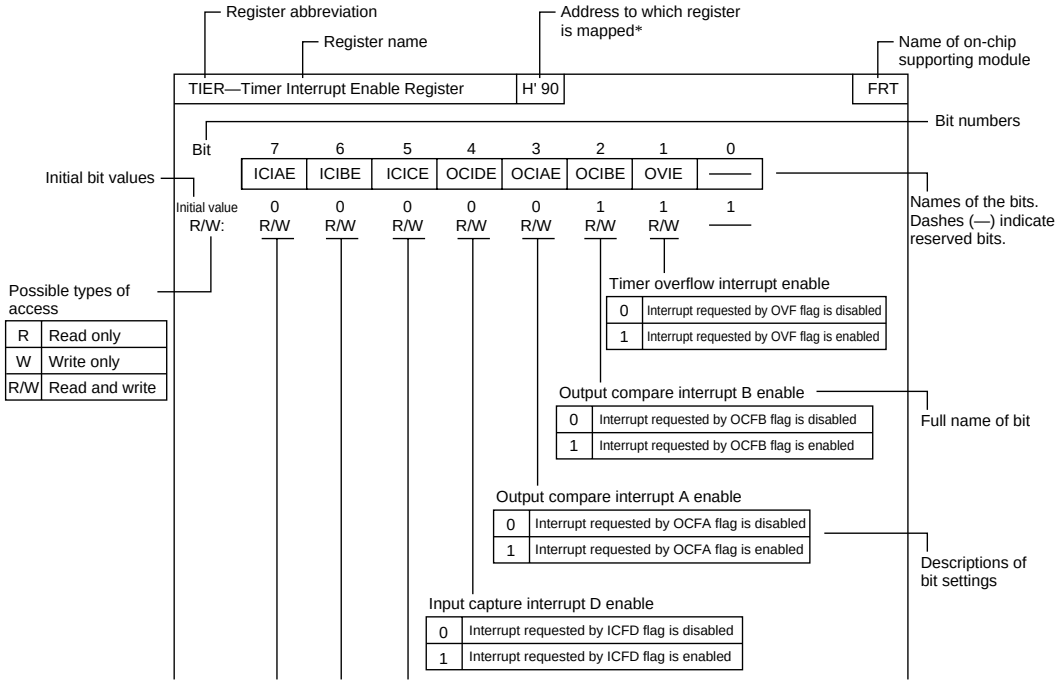
[Legend]

WDT: Watchdog timer

TPC: Programmable timing pattern controller

SCI: Serial communication interface

B.3 Functions



Note: * When the EMC bit in BCR is cleared to 0, addresses of some registers are changed.

P1DDR—Port 1 Data Direction Register	H'EE000	Port 1

Bit	7	6	5	4	3	2	1	0
	$P1_7DDR$	$P1_6DDR$	$P1_5DDR$	$P1_4DDR$	$P1_3DDR$	$P1_2DDR$	$P1_1DDR$	$P1_0DDR$
Modes 1 to 4: Initial value	1	1	1	1	1	1	1	1
Modes 1 to 4: Read/Write	—	—	—	—	—	—	—	—
Modes 5, 7: Initial value	0	0	0	0	0	0	0	0
Modes 5, 7: Read/Write	W	W	W	W	W	W	W	W

Port 1 input/output select

0	Generic input
1	Generic output

P2DDR—Port 2 Data Direction Register	H'EE001	Port 2

Bit	7	6	5	4	3	2	1	0
	$P2_7DDR$	$P2_6DDR$	$P2_5DDR$	$P2_4DDR$	$P2_3DDR$	$P2_2DDR$	$P2_1DDR$	$P2_0DDR$
Modes 1 to 4: Initial value	1	1	1	1	1	1	1	1
Modes 1 to 4: Read/Write	—	—	—	—	—	—	—	—
Modes 5, 7: Initial value	0	0	0	0	0	0	0	0
Modes 5, 7: Read/Write	W	W	W	W	W	W	W	W

Port 2 input/output select

0	Generic input
1	Generic output

P3DDR—Port 3 Data Direction Register	H'EE002	Port 3

Bit	7	6	5	4	3	2	1	0
	$P3_7DDR$	$P3_6DDR$	$P3_5DDR$	$P3_4DDR$	$P3_3DDR$	$P3_2DDR$	$P3_1DDR$	$P3_0DDR$
Initial value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W

Port 3 input/output select

0	Generic input
1	Generic output

P4DDR—Port 4 Data Direction Register	H'EE003	Port 4

Bit	7	6	5	4	3	2	1	0
	$P4_7DDR$	$P4_6DDR$	$P4_5DDR$	$P4_4DDR$	$P4_3DDR$	$P4_2DDR$	$P4_1DDR$	$P4_0DDR$
Initial value	0	0	0	0	0	0	0	0
Read/Write	W	W	W	W	W	W	W	W

Port 4 input/output select

0	Generic input
1	Generic output

P5DDR—Port 5 Data Direction Register	H'EE004	Port 5

Bit	7	6	5	4	3	2	1	0
	—	—	—	—	$P5_3DDR$	$P5_2DDR$	$P5_1DDR$	$P5_0DDR$
Modes 1 to 4 Initial value	1	1	1	1	1	1	1	1
Modes 1 to 4 Read/Write	—	—	—	—	—	—	—	—
Modes 5 , 7 Initial value	1	1	1	1	0	0	0	0
Modes 5 , 7 Read/Write	—	—	—	—	W	W	W	W

Port 5 input/output select

0	Generic input pin
1	Generic output pin

P6DDR—Port 6 Data Direction Register	H'EE005	Port 6

Bit	7	6	5	4	3	2	1	0
	—	$P6_6DDR$	$P6_5DDR$	$P6_4DDR$	$P6_3DDR$	$P6_2DDR$	$P6_1DDR$	$P6_0DDR$
Initial value	1	0	0	0	0	0	0	0
Read/Write	—	W	W	W	W	W	W	W

Port 6 input/output select

0	Generic input
1	Generic output

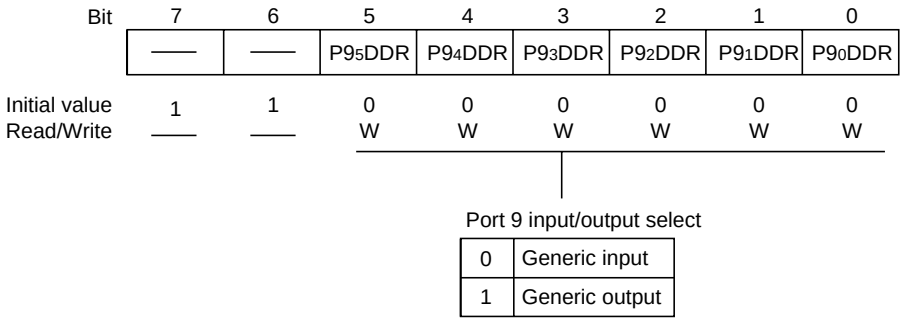
P8DDR—Port 8 Data Direction Register	H'EE007	Port 8

Bit	7	6	5	4	3	2	1	0
	—	—	—	$P8_4DDR$	$P8_3DDR$	$P8_2DDR$	$P8_1DDR$	$P8_0DDR$
Modes 1 to 4 Initial value	1	1	1	1	0	0	0	0
Modes 1 to 4 Read/Write	—	—	—	W	W	W	W	W
Modes 5, 7 Initial value	1	1	1	0	0	0	0	0
Modes 5, 7 Read/Write	—	—	—	W	W	W	W	W

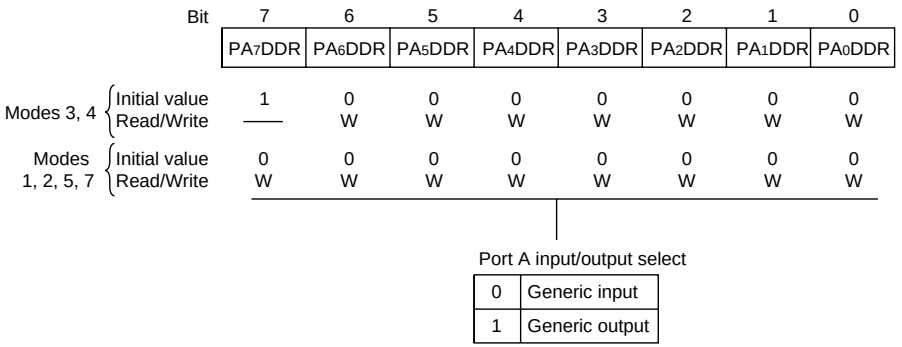
Port 8 input/output select

0	Generic input
1	Generic output

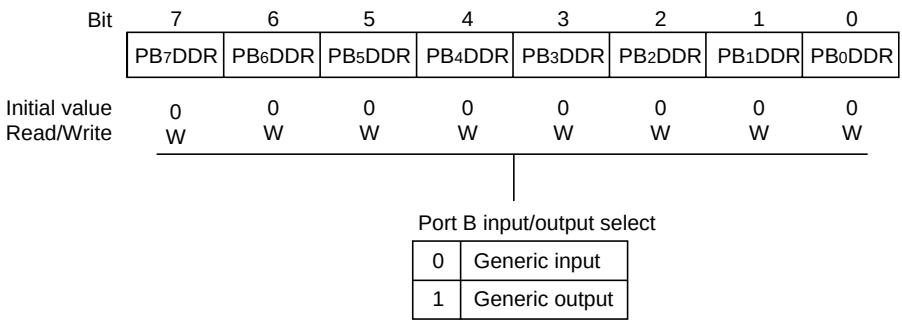
P9DDR—Port 9 Data Direction Register	H'EE008	Port 9



PADDR—Port A Data Direction Register	H'EE009	Port A



PBDDR—Port B Data Direction Register	H'EE00A	Port B



Bit	7	6	5	4	3	2	1	0
	—	—	—	—	—	MDS2	MDS1	MDS0
Initial value	1	1	0	0	0	—*	—*	—*
Read/Write	—	—	—	—	—	R	R	R

Mode select 2 to 0

Bit 2	Bit 1	Bit 0	Operating Mode
MD_2	MD_1	MD_0	
0	0	0	—
		1	Mode 1
	1	0	Mode 2
		1	Mode 3
1	0	0	Mode 4
		1	Mode 5
	1	0	—
		1	Mode 7

Note: * Determined by the state of the mode pins (MD_2 to MD_0).

Bit	7	6	5	4	3	2	1	0
	SSBY	STS2	STS1	STS0	UE	NMIEG	SSOE	RAME
Initial value	0	0	0	0	1	0	0	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

RAM enable

0	On-chip RAM is disabled
1	On-chip RAM is enabled

Software standby output port enable

0	In software standby mode, all address bus and bus control signals are high-impedance
1	In software standby mode, address bus retains output state and bus control signals are fixed high

NMI edge select

0	An interrupt is requested at the falling edge of NMI
1	An interrupt is requested at the rising edge of NMI

User bit enable

0	CCR bit 6 (UI) is used as an interrupt mask bit
1	CCR bit 6 (UI) is used as a user bit

Standby timer select 2 to 0

Bit 6 STS2	Bit 5 STS1	Bit 4 STS0	Standby Timer
0	0	0	Waiting Time = 8,192 states
		1	Waiting Time = 16,384 states
	1	0	Waiting Time = 32,768 states
		1	Waiting Time = 65,536 states
1	0	0	Waiting Time = 131,072 states
		1	Waiting Time = 26,2144 states
	1	0	Waiting Time = 1,024 states
		1	Illegal setting

Software standby

0	SLEEP instruction causes transition to sleep mode
1	SLEEP instruction causes transition to software standby mode

BRCR—Bus Release Control Register | H'EE013 | Bus controller

Bit	7	6	5	4	3	2	1	0
	A23E	A22E	A21E	A20E	——	——	——	BRLE
Modes 1, 2, 7 Initial value	1	1	1	1	1	1	1	0
Modes 1, 2, 7 Read/Write	——	——	——	——	——	——	——	R/W
Modes 3, 4 Initial value	1	1	1	0	1	1	1	0
Modes 3, 4 Read/Write	R/W	R/W	R/W	——	——	——	——	R/W
Mode 5 Initial value	1	1	1	1	1	1	1	0
Mode 5 Read/Write	R/W	R/W	R/W	R/W	——	——	——	R/W

Address 23 to 20 enable

0	Address output
1	Other input/output

Bus release enable

0	The bus cannot be released to an external device
1	The bus can be released to an external device

ISCR—IRQ Sense Control Register | H'EE014 | Interrupt Controller

Bit	7	6	5	4	3	2	1	0
	——	——	IRQ5SC	IRQ4SC	IRQ3SC	IRQ2SC	IRQ1SC	IRQ0SC
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

IRQ_5 to IRQ_0 sense control

0	Interrupts are requested when $\overline{IRQ}_5$ to $\overline{IRQ}_0$ are low
1	Interrupts are requested by falling-edge input at $\overline{IRQ}_5$ to $\overline{IRQ}_0$

IER—IRQ Enable Register	H'EE015	Interrupt Controller

Bit	7	6	5	4	3	2	1	0
	———	———	IRQ5E	IRQ4E	IRQ3E	IRQ2E	IRQ1E	IRQ0E
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

IRQ_5 to IRQ_0 enable

0	IRQ_5 to IRQ_0 interrupts are disabled
1	IRQ_5 to IRQ_0 interrupts are enabled

ISR—IRQ Status Register	H'EE016	Interrupt Controller

Bit	7	6	5	4	3	2	1	0
	———	———	IRQ5F	IRQ4F	IRQ3F	IRQ2F	IRQ1F	IRQ0F
Initial value	0	0	0	0	0	0	0	0
Read/Write	———	———	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/(W)*

IRQ5 to IRQ0 flags

Bits 5 to 0 IRQ5F to IRQ0F	Setting and Clearing Conditions
0	[Clearing conditions] • Read IRQnF when IRQnF = 1, then write 0 in IRQnF. • IRQnSC = 0, $\overline{IRQn}$ input is high, and interrupt exception handling is being carried out. • IRQnSC = 1 and IRQn interrupt exception handling is being carried out.
1	[Setting conditions] • IRQnSC = 0 and $\overline{IRQn}$ input is low. • IRQnSC = 1 and $\overline{IRQn}$ input changes from high to low.

(n = 5 to 0)

Note: * Only 0 can be written, to clear the flag.

IPRA—Interrupt Priority Register A

H'EE018	Interrupt Controller

Bit	7	6	5	4	3	2	1	0
	IPRA7	IPRA6	IPRA5	IPRA4	IPRA3	IPRA2	IPRA1	IPRA0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Priority level A7 to A0

0	Priority level 0 (low priority)
1	Priority level 1 (high priority)

• Interrupt sources controlled by each bit

	Bit	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
		IPRA7	IPRA6	IPRA5	IPRA4	IPRA3	IPRA2	IPRA1	IPRA0
IPRA	Interrupt source	IRQ_0	IRQ_1	IRQ_2, IRQ_3	IRQ_4, IRQ_5	WDT, DRAM interface, A/D converter	16-bit timer channel 0	16-bit timer channel 1	16-bit timer channel 2

IPRB—Interrupt Priority Register B

H'EE019	Interrupt Controller

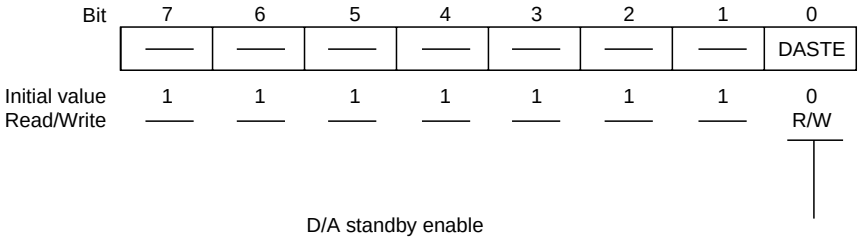
Bit	7	6	5	4	3	2	1	0
	IPRB7	IPRB6	IPRB5	———	IPRB3	IPRB2	IPRB1	———
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Priority level B7 to B5, B3 to B1

0	Priority level 0 (low priority)
1	Priority level 1 (high priority)

• Interrupt sources controlled by each bit

	Bit	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
		IPRB7	IPRB6	IPRB5	———	IPRB3	IPRB2	IPRB1	———
IPRB	Interrupt source	8-bit timer channels 0 and 1	8-bit timer channels 2 and 3	DMAC	———	SCI channel 0	SCI channel 1	SCI channel 2	———



D/A standby enable

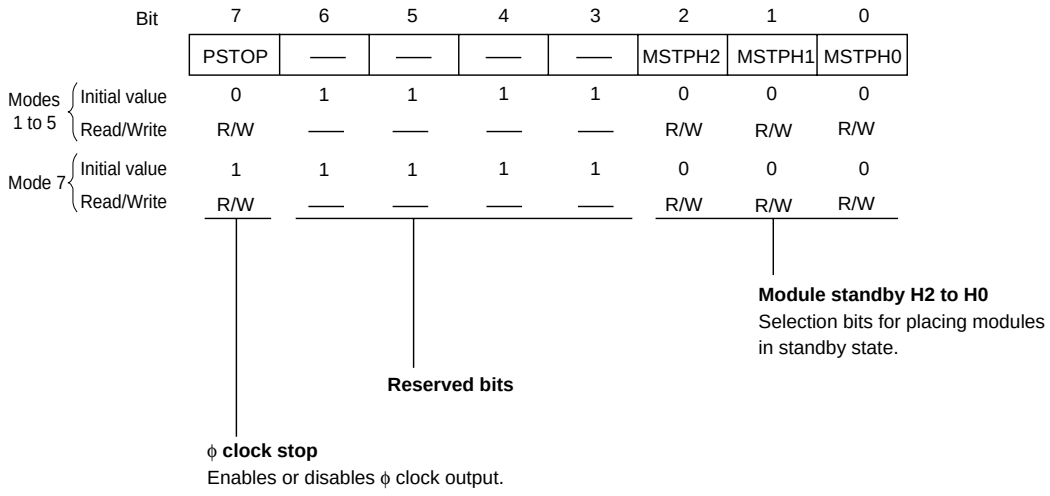
0	D/A output is disabled in software standby mode	(Initial value)
1	D/A output is enabled in software standby mode	

Bit	7	6	5	4	3	2	1	0
	—	—	—	—	—	—	DIV1	DIV0
Initial value	1	1	1	1	1	1	0	0
Read/Write	—	—	—	—	—	—	R/W	R/W

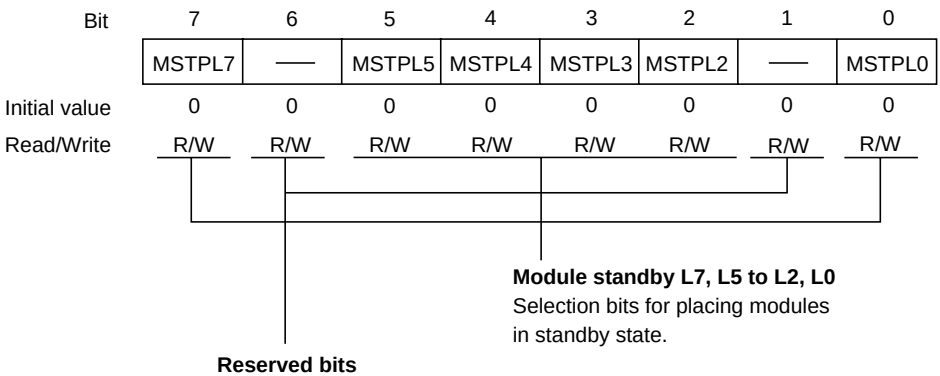
Divide 1 and 0

Bit 1	Bit 0	Frequency Division Ratio
DIV1	DIV0	
0	0	1/1 (Initial value)
	1	1/2
1	0	1/4
	1	1/8

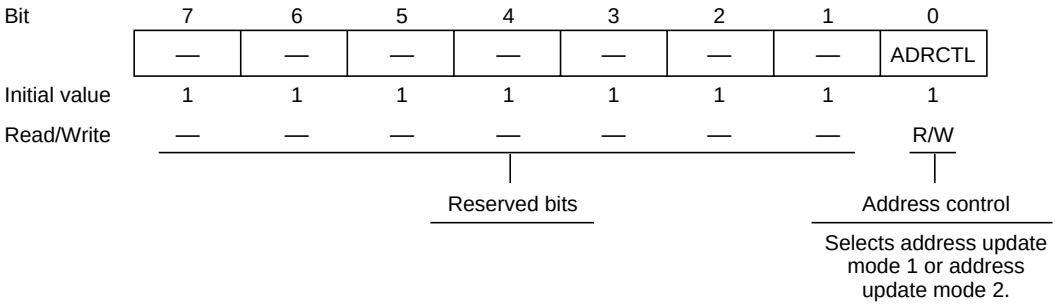
MSTCRH—Module Standby Control Register H	H'EE01C	System control



MSTCRL—Module Standby Control Register L	H'EE01D	System control

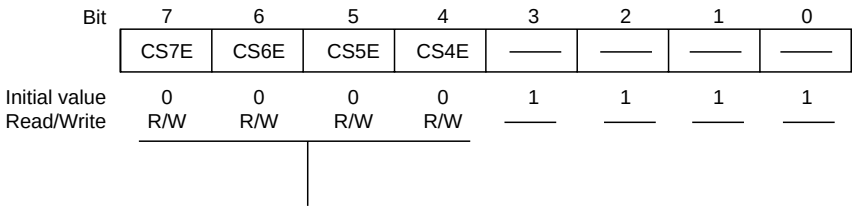


ADRCR—Address Control Register	H'EE01E	Bus controller



ADRCTL	Description
0	Address update mode 2 is selected
1	Address update mode 1 is selected (Initial value)

CSCR—Chip Select Control Register	H'EE01F	Bus controller



Bit n CSnE	Description
0	Output of chip select signal CSn is disabled (Initial value)
1	Output of chip select signal CSn is enabled

(n = 7 to 4)

ABWCR—Bus Width Control Register	H'EE020	Bus controller

Bit	7	6	5	4	3	2	1	0
	ABW7	ABW6	ABW5	ABW4	ABW3	ABW2	ABW1	ABW0
Modes 1, 3, 5, 7 Initial value	1	1	1	1	1	1	1	1
Modes 2, 4 Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Area 7 to 0 bus width control

Bits 7 to 0	Bus Width of Access Area
ABW7 to ABW0	
0	Areas 7 to 0 are 16-bit access areas
1	Areas 7 to 0 are 8-bit access areas

ASTCR—Access State Control Register	H'EE021	Bus controller

Bit	7	6	5	4	3	2	1	0
	AST7	AST6	AST5	AST4	AST3	AST2	AST1	AST0
Initial value	1	1	1	1	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Area 7 to 0 access state control

Bits 7 to 0	Number of States in Access Area
AST7 to AST0	
0	Areas 7 to 0 are two-state access areas
1	Areas 7 to 0 are three-state access areas

Bit	7	6	5	4	3	2	1	0
	W71	W70	W61	W60	W51	W50	W41	W40
Initial value	1	1	1	1	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Area 4 wait control 1 and 0

0	0	No program wait is inserted
	1	1 program wait state is inserted
1	0	2 program wait states are inserted
	1	3 program wait states are inserted

Area 5 wait control 1 and 0

0	0	No program wait is inserted
	1	1 program wait state is inserted
1	0	2 program wait states are inserted
	1	3 program wait states are inserted

Area 6 wait control 1 and 0

0	0	No program wait is inserted
	1	1 program wait state is inserted
1	0	2 program wait states are inserted
	1	3 program wait states are inserted

Area 7 wait control 1 and 0

0	0	No program wait is inserted
	1	1 program wait state is inserted
1	0	2 program wait states are inserted
	1	3 program wait states are inserted

Bit	7	6	5	4	3	2	1	0
	W31	W30	W21	W20	W11	W10	W01	W00
Initial value	1	1	1	1	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Area 0 wait control 1 and 0

0	0	No program wait is inserted
	1	1 program wait state is inserted
1	0	2 program wait states are inserted
	1	3 program wait states are inserted

Area 1 wait control 1 and 0

0	0	No program wait is inserted
	1	1 program wait state is inserted
1	0	2 program wait states are inserted
	1	3 program wait states are inserted

Area 2 wait control 1 and 0

0	0	No program wait is inserted
	1	1 program wait state is inserted
1	0	2 program wait states are inserted
	1	3 program wait states are inserted

Area 3 wait control 1 and 0

0	0	No program wait is inserted
	1	1 program wait state is inserted
1	0	2 program wait states are inserted
	1	3 program wait states are inserted

Bit	7	6	5	4	3	2	1	0
	ICIS1	ICIS0	BROME	BRSTS1	BRSTS0	EMC	RDEA	WAITE
Initial value	1	1	0	0	0	1	1	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Wait pin enable

0	$\overline{\text{WAIT}}$ pin wait input is disabled
1	$\overline{\text{WAIT}}$ pin wait input is enabled

Area division unit select

0	Area divisions are as follows: Area 0: 2 MB Area 4: 1.93 MB Area 1: 2 MB Area 5: 4 kB Area 2: 8 MB Area 6: 23.75 kB Area 3: 2 MB Area 7: 22 B
1	Areas 0 to 7 are the same size (2 MB)

Expansion memory map control

0	Memory map in figure 3.2 in section 3.6 (Memory Map in Each Operating Mode)
1	Memory map in figure 3.1 in section 3.6 (Memory Map in Each Operating Mode)

Burst cycle select 0

0	Max. 4 words in burst access
1	Max. 8 words in burst access

Burst cycle select 1

0	Burst access cycle comprises 2 states
1	Burst access cycle comprises 3 states

Burst ROM enable

0	Area 0 is a basic bus interface area
1	Area 0 is a burst ROM interface area

Idle cycle insertion 0

0	No idle cycle is inserted in case of consecutive external read and write cycles
1	Idle cycle is inserted in case of consecutive external read and write cycles

Idle cycle insertion 1

0	No idle cycle is inserted in case of consecutive external read cycles for different areas
1	Idle cycle is inserted in case of consecutive external read cycles for different areas

Bit	7	6	5	4	3	2	1	0
	DRAS2	DRAS1	DRAS0	—	BE	RDM	SRFMD	RFSHE
Initial value	0	0	0	1	0	0	0	0
Read/Write	R/W	R/W	R/W	—	R/W	R/W	R/W	R/W

Refresh pin enable

0	$\overline{\text{RFSH}}$ pin refresh signal output is disabled
1	$\overline{\text{RFSH}}$ pin refresh signal output is enabled

Self-refresh mode

0	DRAM self-refreshing is disabled in software standby mode
1	DRAM self-refreshing is enabled in software standby mode

RAS down mode

0	DRAM interface: RAS up mode selected
1	DRAM interface: RAS down mode selected

Burst access enable

0	Burst disabled (always full access)
1	DRAM space access performed in fast page mode

DRAM area select

DRAS2	DRAS1	DRAS0	Area 5	Area 4	Area 3	Area 2
0	0	0	Normal	Normal	Normal	Normal
		1	Normal	Normal	Normal	DRAM space ($\overline{\text{CS}}_2$)
	1	0	Normal	Normal	DRAM space ($\overline{\text{CS}}_3$)	DRAM space ($\overline{\text{CS}}_2$)
		1	Normal	Normal	DRAM space($\overline{\text{CS}}_2$)*	
1	0	0	Normal	DRAM space ($\overline{\text{CS}}_4$)	DRAM space ($\overline{\text{CS}}_3$)	DRAM space ($\overline{\text{CS}}_2$)
		1	DRAM space ($\overline{\text{CS}}_5$)	DRAM space ($\overline{\text{CS}}_4$)	DRAM space ($\overline{\text{CS}}_3$)	DRAM space ($\overline{\text{CS}}_2$)
	1	0	DRAM space($\overline{\text{CS}}_4$)*		DRAM space($\overline{\text{CS}}_2$)*	
		1	DRAM space($\overline{\text{CS}}_2$)*			

Note: *A single $\overline{\text{CSn}}$ pin serves as a common $\overline{\text{RAS}}$ output pin for a number of areas. Unused $\overline{\text{CSn}}$ pins can be used as input/output ports.

Bit	7	6	5	4	3	2	1	0
	MXC1	MXC0	CSEL	RCYCE	—	TPC	RCW	RLW
Initial value	0	0	0	0	1	0	0	0
Read/Write	R/W	R/W	R/W	R/W	—	R/W	R/W	R/W

Refresh cycle wait control

0	Wait state (T_{RW}) insertion is disabled
1	1 wait state (T_{RW}) is inserted

$\overline{RAS}$-$\overline{CAS}$ wait

0	Wait state (T_{rw}) insertion is disabled
1	1 wait state (T_{rw}) is inserted

TP cycle control

0	1-state precharge cycle is inserted
1	2-state precharge cycle is inserted

Refresh cycle enable

0	Refresh cycles are disabled
1	DRAM refresh cycles are enabled

$\overline{CAS}$ output pin select

0	PB4 and PB5 selected as $\overline{UCAS}$ and $\overline{LCAS}$ output pins
1	$\overline{HWR}$ and $\overline{LWR}$ selected as $\overline{UCAS}$ and $\overline{LCAS}$ output pins

Multiplex control 1 and 0

MXC1	MXC0	Description		
0	0	Column address: 8 bits		
		Compared address:		
		Modes 1, 2	8-bit access space	A_{19} to A_8
			16-bit access space	A_{19} to A_9
		Modes 3, 4, 5	8-bit access space	A_{23} to A_8
			16-bit access space	A_{23} to A_9
	1	Column address: 9 bits		
		Compared address:		
		Modes 1, 2	8-bit access space	A_{19} to A_9
			16-bit access space	A_{19} to A_{10}
		Modes 3, 4, 5	8-bit access space	A_{23} to A_9
			16-bit access space	A_{23} to A_{10}
1	0	Column address: 10 bits		
		Compared address:		
		Modes 1, 2	8-bit access space	A_{19} to A_{10}
			16-bit access space	A_{19} to A_{11}
		Modes 3, 4, 5	8-bit access space	A_{23} to A_{10}
			16-bit access space	A_{23} to A_{11}
	1	Illegal setting		

Bit	7	6	5	4	3	2	1	0
	CMF	CMIE	CKS2	CKS1	CKS0	—	—	—
Initial value	0	0	0	0	0	1	1	1
Read/Write	R/(W)*	R/W	R/W	R/W	R/W	—	—	—

Refresh counter clock select

CKS2	CKS1	CKS0	Description
0	0	0	Count operation halted
		1	φ/2 used as counter clock
	1	0	φ/8 used as counter clock
		1	φ/32 used as counter clock
1	0	0	φ/128 used as counter clock
		1	φ/512 used as counter clock
	1	0	φ/2048 used as counter clock
		1	φ/4096 used as counter clock

Compare match interrupt enable

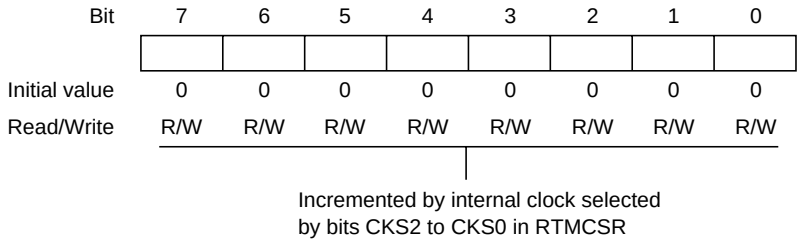
0	The CMI interrupt requested by the CMF flag is disabled
1	The CMI interrupt requested by the CMF flag is enabled

Compare match flag

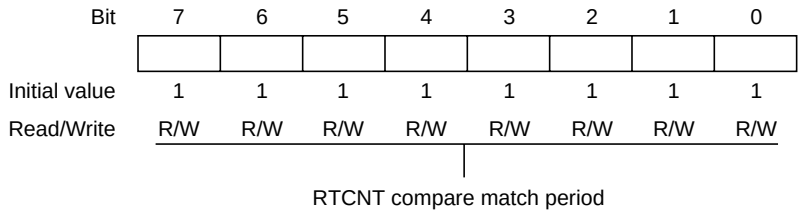
0	[Clearing conditions] • Cleared by a reset and in standby mode • Cleared by reading CMF when CMF = 1, then writing 0 in CMF
1	[Setting condition] When RTCNT = RTCOR

Note: * Only 0 can be written to clear the flag.

RTCNT—Refresh Timer Counter	H'EE029	DRAM interface



RTCOR—Refresh Time Constant Register	H'EE02A	DRAM interface



Note: Only byte access can be used on this register.

Bit	7	6	5	4	3	2	1	0
	$P2_7PCR$	$P2_6PCR$	$P2_5PCR$	$P2_4PCR$	$P2_3PCR$	$P2_2PCR$	$P2_1PCR$	$P2_0PCR$
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Port 2 input pull-up control 7 to 0

0	Input pull-up transistor is off
1	Input pull-up transistor is on

Note: Valid when the corresponding P2DDR bit is cleared to 0 (designating generic input).

P4PCR—Port 4 Input Pull-Up Control Register	H'EE03E	Port 4

Bit	7	6	5	4	3	2	1	0
	$P4_7PCR$	$P4_6PCR$	$P4_5PCR$	$P4_4PCR$	$P4_3PCR$	$P4_2PCR$	$P4_1PCR$	$P4_0PCR$
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Port 4 input pull-up control 7 to 0

0	Input pull-up transistor is off
1	Input pull-up transistor is on

Note: Valid when the corresponding P4DDR bit is cleared to 0 (designating generic input).

P5PCR—Port 5 Input Pull-Up Control Register	H'EE03F	Port 5

Bit	7	6	5	4	3	2	1	0
	—	—	—	—	$P5_3PCR$	$P5_2PCR$	$P5_1PCR$	$P5_0PCR$
Initial value	1	1	1	1	0	0	0	0
Read/Write	—	—	—	—	R/W	R/W	R/W	R/W

Port 5 input pull-up control 3 to 0

0	Input pull-up transistor is off
1	Input pull-up transistor is on

Note: Valid when the corresponding P5DDR bit is cleared to 0 (designating generic input).

	Bit	7	6	5	4	3	2	1	0
		—	—	—	—	RAMS	RAM2	RAM1	RAM0
Modes 1 to 4	Initial value	1	1	1	1	0	0	0	0
	R/W	—	—	—	—	R	R	R	—
Modes 5, 7	Initial value	1	1	1	1	0	0	0	0
	R/W	—	—	—	—	R/W*	R/W*	R/W*	R/W*

Reserved bits

RAM select, RAMS to RAM0

Bit 3	Bit 2	Bit 1	Bit 0	RAM Area	RAM Emulation Status
RAMS	RAM2	RAM1	RAM0		
0	0/1	0/1	0/1	H'FFFFE000 to H'FFFFEFFF	Emulation
1	0	0	0	H'00000000 to H'00000FFF	Mapping RAM
			1	H'00001000 to H'00001FFF	
		1	0	H'00002000 to H'00002FFF	
			1	H'00003000 to H'00003FFF	
	1	0	0	H'00004000 to H'00004FFF	
			1	H'00005000 to H'00005FFF	
		1	0	H'00006000 to H'00006FFF	
			1	H'00007000 to H'00007FFF	

Note: * In user boot mode, flash memory emulation by RAM is not supported; these bits can be modified, but must not be set to 1.

Bit	7	6	5	4	3	2	1	0
	FWE	——	——	FLER	——	——	——	SCO
Initial value	1/0	0	0	0	0	0	0	0
Read/Write	R	R	R	R	R	R	R	(R)/W

Reserved bits

Reserved bits

Source program copy operation

0	On-chip programming/erase control program is not downloaded to on-chip RAM (Initial value) [Clearing condition] When download has finished
1	Request to download on-chip programming/erase control program to on-chip RAM is generated [Setting conditions] When 1 is written while all of the following conditions are satisfied • H'A5 is written to FKEY • Program being executed is in on-chip RAM • Not in RAM emulation mode (RAMS in RAMER is 0)

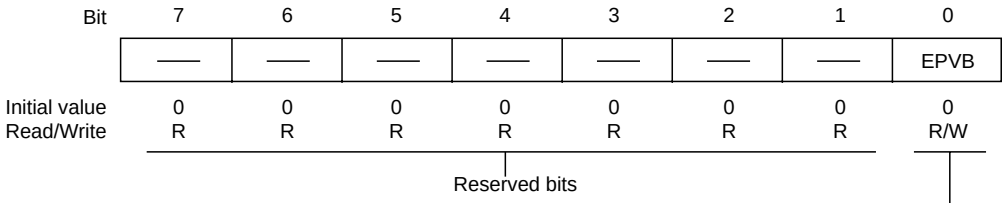
Flash memory error

0	Flash memory operates normally. Program/erase protection (error protection) for flash memory is disabled. [Clearing condition] Power-on reset or in hardware standby mode
1	Erroe occurred during programming/erasing of flash memory. Program/erase protection (error protection) for flash memory is enabled. [Setting conditions] See section 18.6.3, Error Protection

Flash write enable

0	Low level is input to FWE pin (hardware-protection state)
1	High level is input to FWE pin

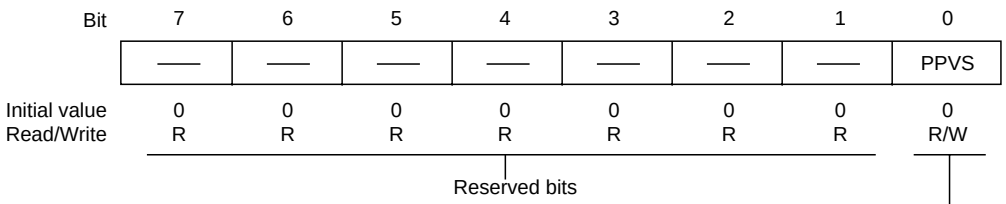
FECS—Flash Erase Code Register	H'EE0B2	Flash Memory



Erase pulse verify block

0	On-chip erase program is not selected (Initial value) [Clearing condition] When transfer has finished
1	On-chip erase program is selected

FPCS—Flash Program Code Select Register	H'EE0B1	Flash Memory



Program pulse verify block

0	On-chip programming control program is not selected (Initial value) [Clearing condition] When transfer has finished
1	On-chip programming control program is selected

FKEY—Flash Key Code Register

	H'EE0B4	Flash Memory

Bit	7	6	5	4	3	2	1	0
	K7	K6	K5	K4	K3	K2	K1	K0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Key code

H'A5	Write to SC0 bit is enabled (SC0 bit can be set only when FKEY is H'A5)
H'5A	Programming/erase is enabled (software-protection state when FKEY is not H'5A)
H'00	Initial value

FMATS—Flash Mat Select Register

	H'EE0B5	Flash Memory

Bit	7	6	5	4	3	2	1	0	
	MS7	MS6	MS5	MS4	MS3	MS2	MS1	MS0	
Initial value	0	0	0	0	0	0	0	0	(Mode other than user boot mode)
Initial value	1	0	1	0	1	0	1	0	(User boot mode)
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	

Mat select

H'AA	User boot mode is selected (user mat selection when FMATS is not H'AA). Initial value when started up in user boot mode.
H'00	Initial value when not started up in user boot mode (user mat selection)

[Programmable condition] Program being executed is in on-chip RAM

Bit	7	6	5	4	3	2	1	0
	TDER	TDA6	TDA5	TDA4	TDA3	TDA2	TDA1	TDA0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Transfer Destination Address

Bit 6 to 0 TDA6 to TDA0	Description
H'00	Sets download start address to H'FFEF20 (Initial value)
H'01	Sets download start address to H'FFDF20
H'02	Sets download start address to H'FFCF20
H'03	Sets download start address to H'FFBF20
H'04 to H'FF	These settings should not be used. Using one of these settings will cause bit 7 (TDER) to be set to 1, halting download processing.

Transfer Destination Address Setting Error

0	TDA6 to TDA0 set to normal values (Initial setting)
1	Indicates that the setting values of TDER and TDA6 to TDA0 are in the range H'04 to H'FF, causing the download to halt.

Bit	7	6	5	4	3	2	1	0
	FVCHGE	——	——	——	FVSEL3	FVSEL2	FVSEL1	FVSEL0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

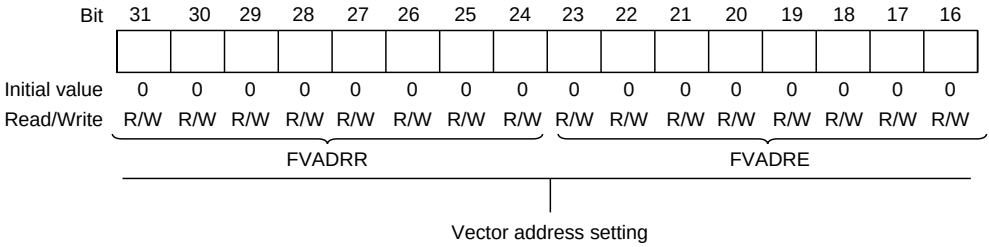
Reserved bits

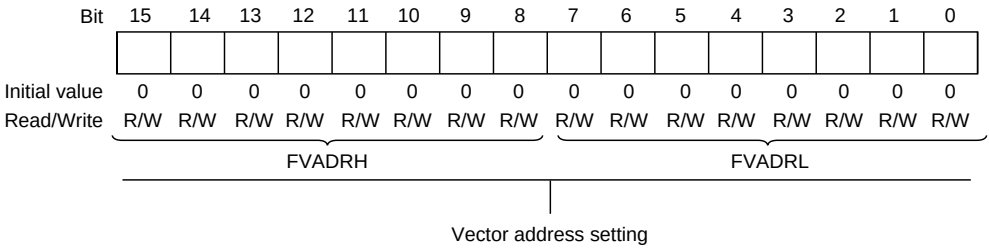
Interrut source selection

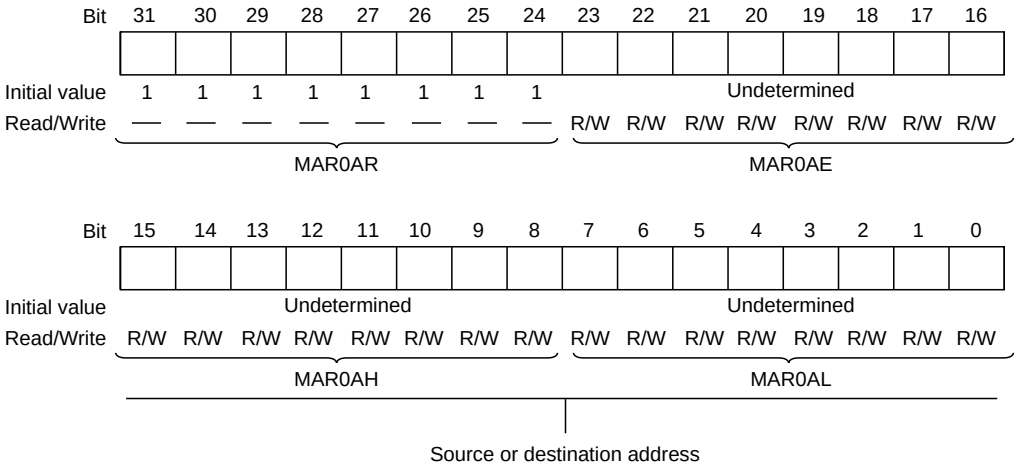
Bit 3	Bit 2	Bit 1	Bit 0	Description
FVSEL3	FVSEL2	FVSEL1	FVSEL0	
0	0	0	0	Vector table data is in area 0 (H'00001C to H'00004F) (Initial value)
0	0	0	1	Setting prohibited
0	0	1	——	
0	1	——	——	
1	0	0	0	Vector table data is in internal I/O registers (FVADDR to FVADRL)
1	0	0	1	Setting prohibited
1	0	1	——	
1	1	——	——	

Vector switching function enable

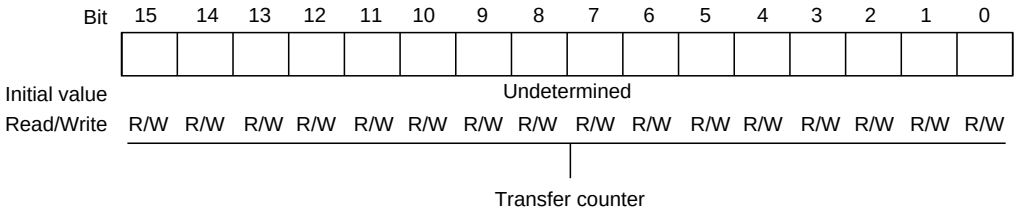
0	Function to change space from which to read vector table data is disable (Initial value)
1	Function to change space from which to read vector table data is enabled


Bit 31 30 29 28 27 26 25 24 23 22 21 20 19 18 17 16
Initial value 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0
Read/Write R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W
FVADRR
FVADRE
Vector address setting

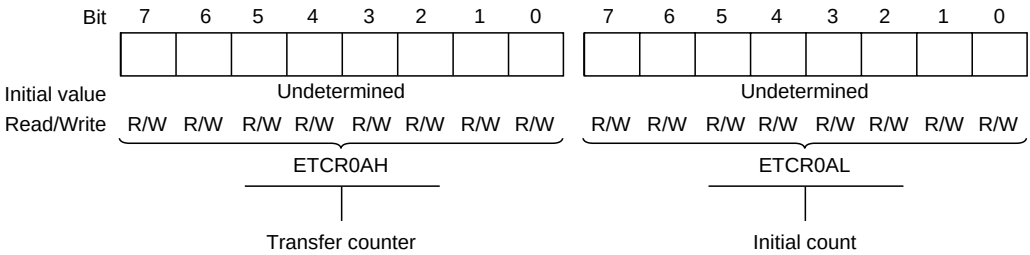

Bit 15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0
Initial value 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0
Read/Write R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W
FVADRH
FVADRL
Vector address setting


Bit 31 30 29 28 27 26 25 24 23 22 21 20 19 18 17 16
Initial value 1 1 1 1 1 1 1 1 Undetermined
Read/Write — — — — — — — — R/W R/W R/W R/W R/W R/W R/W R/W
MAR0AR
MAR0AE
Bit 15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0
Initial value Undetermined Undetermined
Read/Write R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W
MAR0AH
MAR0AL
Source or destination address

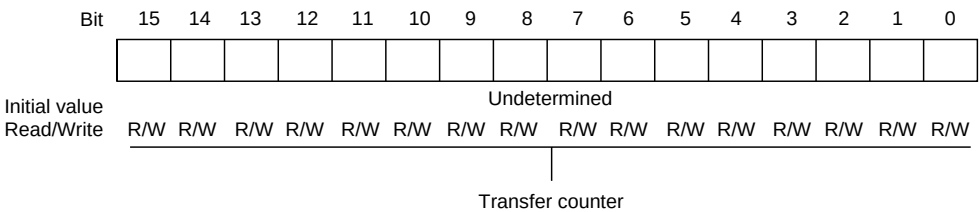
- Short address mode
  - — I/O mode and idle mode



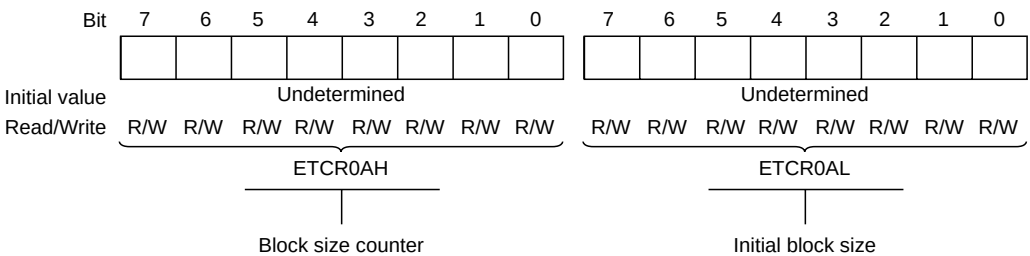
  - — Repeat mode



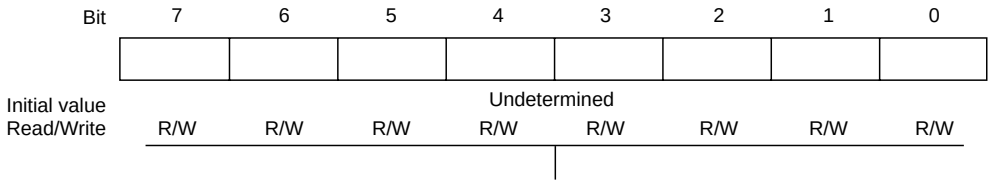
- Full address mode
  - — Normal mode



  - — Block transfer mode



IOAR0A—I/O Address Register 0A	H'FFF26	DMAC0



Short address mode : source or destination address

Full address mode : not used

- Short address mode

Bit	7	6	5	4	3	2	1	0
	DTE	DTSZ	DTID	RPE	DTIE	DTS2	DTS1	DTS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Data transfer select

Bit 2	Bit 1	Bit 0	Data Transfer Activation Source
DTS2	DTS1	DTS0	
0	0	0	Compare match/input capture A interrupt from 16-bit timer channel 0
		1	Compare match/input capture A interrupt from 16-bit timer channel 1
	1	0	Compare match/input capture A interrupt from 16-bit timer channel 2
		1	A/D converter conversion end interrupt
1	0	0	SCI0 transmit-data-empty interrupt
		1	SCI0 receive-data-full interrupt
	1	0	Transfer in full address mode
		1	Transfer in full address mode

Data transfer interrupt enable

0	Interrupt requested by DTE bit is disabled
1	Interrupt requested by DTE bit is enabled

Repeat enable

RPE	DTIE	Description
0	0	I/O mode
	1	
1	0	Repeat mode
	1	Idle mode

Data transfer increment/decrement

0	Incremented: If DTSZ = 0, MAR is incremented by 1 after each transfer If DTSZ = 1, MAR is incremented by 2 after each transfer
1	Decremented: If DTSZ = 0, MAR is decremented by 1 after each transfer If DTSZ = 1, MAR is decremented by 2 after each transfer

Data transfer size

0	Byte-size transfer
1	Word-size transfer

Data transfer enable

0	Data transfer is disabled
1	Data transfer is enabled

- Full address mode

Bit	7	6	5	4	3	2	1	0
	DTE	DTSZ	SAID	SAIDE	DTIE	DTS2A	DTS1A	DTS0A
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Data transfer select 0A

0	Normal mode
1	Block transfer mode

Data transfer select 2A and 1A

Set both bits to 1

Data transfer interrupt enable

0	Interrupt requested by DTE bit is disabled
1	Interrupt requested by DTE bit is enabled

Source address increment/decrement (bit 5)

Source address increment/decrement enable (bit 4)

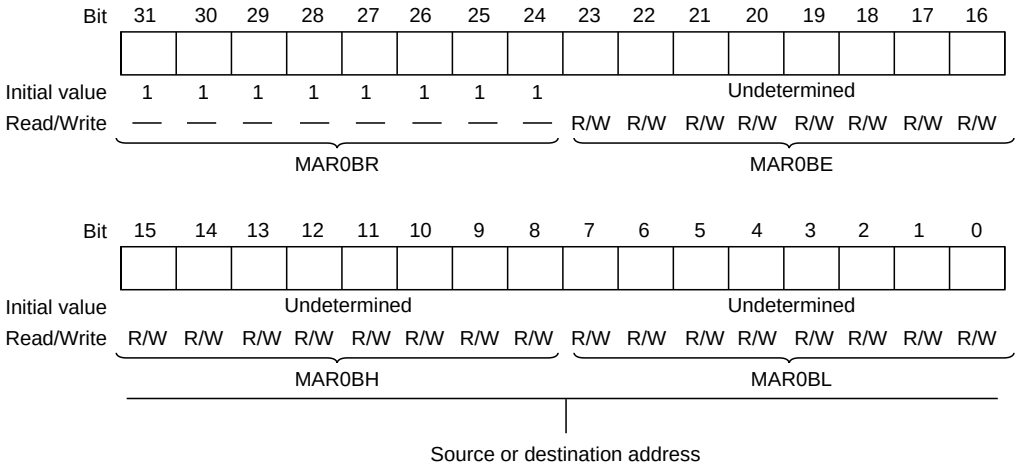
Bit 5 SAID	Bit 4 SAIDE	Increment/Decrement Enable
0	0	MARA is held fixed
	1	Incremented: If DTSZ = 0, MARA is incremented by 1 after each transfer If DTSZ = 1, MARA is incremented by 2 after each transfer
1	0	MARA is held fixed
	1	Decremented: If DTSZ = 0, MARA is decremented by 1 after each transfer If DTSZ = 1, MARA is decremented by 2 after each transfer

Data transfer size

0	Byte-size transfer
1	Word-size transfer

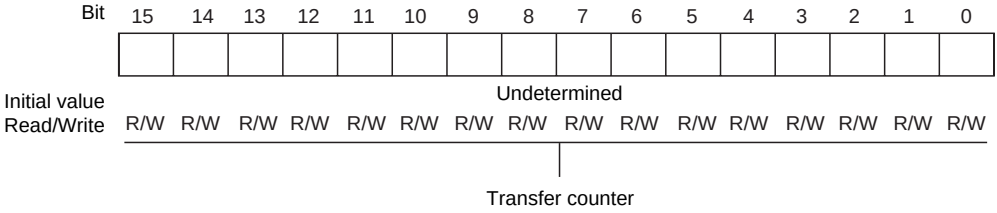
Data transfer enable

0	Data transfer is disabled
1	Data transfer is enabled

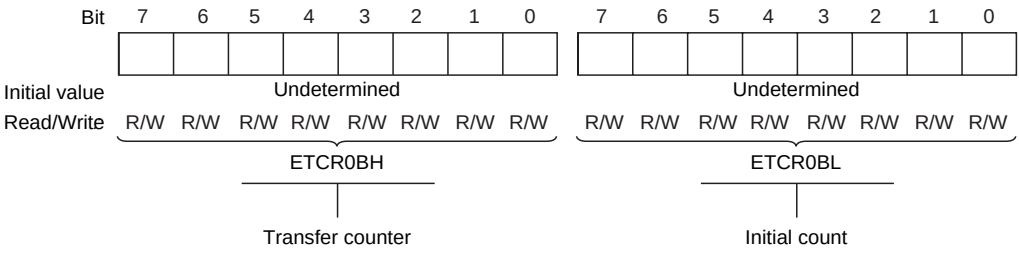

Bit 31 30 29 28 27 26 25 24 23 22 21 20 19 18 17 16
Initial value 1 1 1 1 1 1 1 1 Undetermined
Read/Write — — — — — — — — R/W R/W R/W R/W R/W R/W R/W R/W
MAR0BR
MAR0BE
Bit 15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0
Initial value Undetermined Undetermined
Read/Write R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W R/W
MAR0BH
MAR0BL
Source or destination address

- Short address mode

  — I/O mode and idle mode

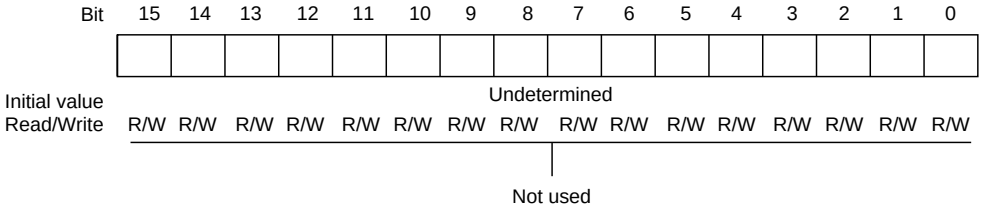


  — Repeat mode

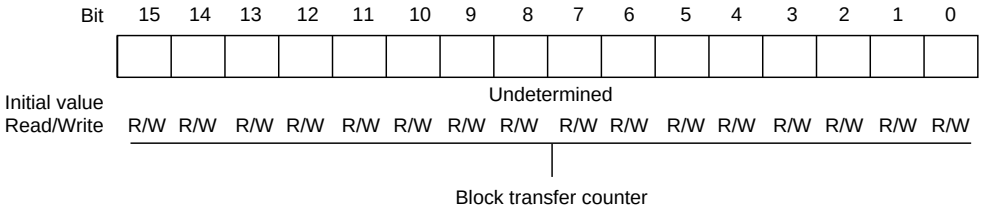


- Full address mode

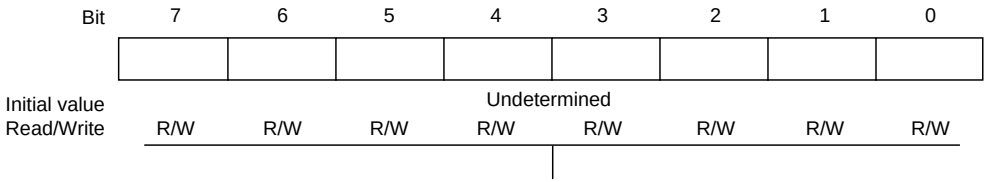
  — Normal mode



  — Block transfer mode



IOAR0B—I/O Address Register 0B	H'FFF2E	DMAC0



Short address mode : source or destination address

Full address mode : not used

- Short address mode

Bit	7	6	5	4	3	2	1	0
	DTE	DTSZ	DTID	RPE	DTIE	DTS2	DTS1	DTS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Data transfer select

Bit 2	Bit 1	Bit 0	Data Transfer Activation Source
DTS2	DTS1	DTS0	
0	0	0	Compare match/input capture A interrupt from 16-bit timer channel 0
		1	Compare match/input capture A interrupt from 16-bit timer channel 1
	1	0	Compare match/input capture A interrupt from 16-bit timer channel 2
		1	A/D converter conversion end interrupt
1	0	0	SCI0 transmit-data-empty interrupt
		1	SCI0 receive-data-full interrupt
	1	0	Falling edge of $\overline{\text{DREQ}}$ input
		1	Low level of $\overline{\text{DREQ}}$ input

Data transfer interrupt enable

0	Interrupt requested by DTE bit is disabled
1	Interrupt requested by DTE bit is enabled

Repeat enable

RPE	DTIE	Description
0	0	I/O mode
	1	
1	0	Repeat mode
	1	Idle mode

Data transfer increment/decrement

0	Incremented: If DTSZ = 0, MAR is incremented by 1 after each transfer If DTSZ = 1, MAR is incremented by 2 after each transfer
1	Decremented: If DTSZ = 0, MAR is decremented by 1 after each transfer If DTSZ = 1, MAR is decremented by 2 after each transfer

Data transfer size

0	Byte-size transfer
1	Word-size transfer

Data transfer enable

0	Data transfer is disabled
1	Data transfer is enabled

- Full address mode

Bit	7	6	5	4	3	2	1	0
	DTME	———	DAID	DAIDE	TMS	DTS2B	DTS1B	DTS0B
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Data transfer master enable

0	Data transfer is disabled
1	Data transfer is enabled

Data transfer select 2B to 0B

Bit 2	Bit 1	Bit 0	Data Transfer Activation Source	
DTS2B	DTS1B	DTS0B	Normal Mode	Block Transfer Mode
0	0	0	Auto-request (burst mode)	Compare match/input capture A interrupt from 16-bit timer channel 0
		1	Not available	Compare match/input capture A interrupt from 16-bit timer channel 1
	1	0	Auto-request (cycle-steal mode)	Compare match/input capture A interrupt from 16-bit timer channel 2
		1	Not available	A/D converter conversion end interrupt
1	0	0	Not available	Not available
		1	Not available	Not available
	1	0	Falling edge input of $\overline{\text{DREQ}}$	Falling edge input of $\overline{\text{DREQ}}$
		1	Low level input at $\overline{\text{DREQ}}$	Not available

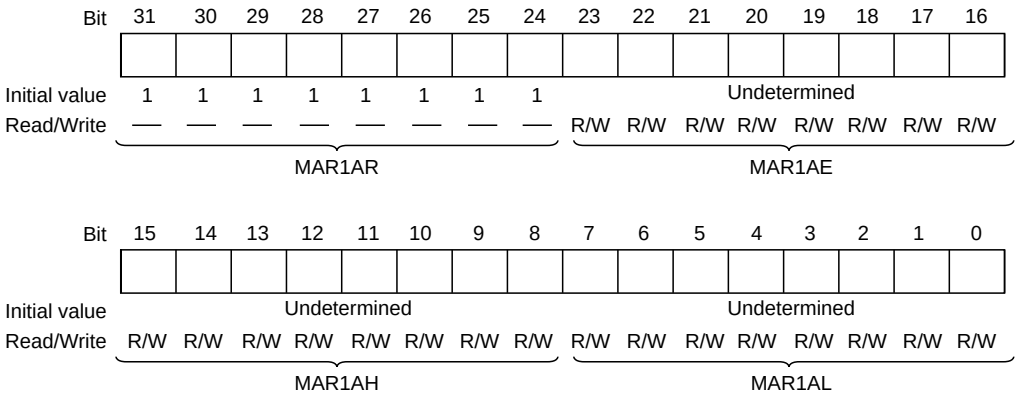
Transfer mode select

0	Destination is the block area in block transfer mode
1	Source is the block area in block transfer mode

Destination address increment/decrement (bit 5)
Destination address increment/decrement enable (bit 4)

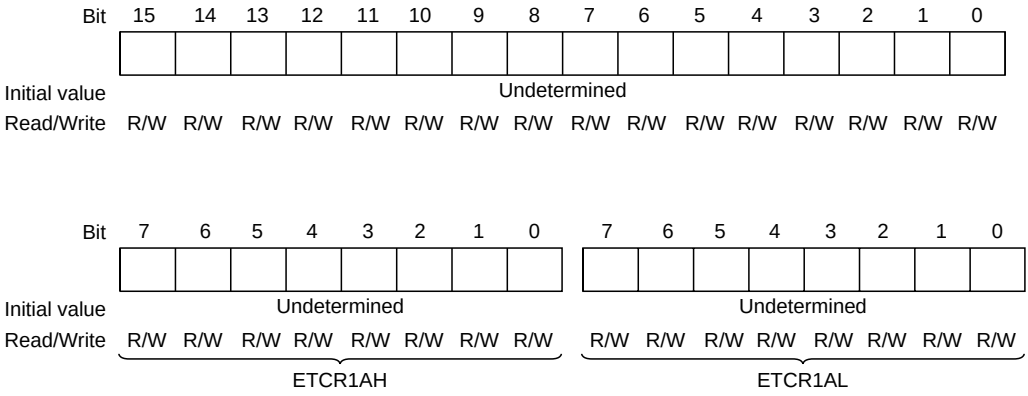
Bit 5	Bit 4	Increment/Decrement Enable
DAID	DAIDE	
0	0	MARB is held fixed
	1	Incremented: If DTSZ = 0, MARB is incremented by 1 after each transfer If DTSZ = 1, MARB is incremented by 2 after each transfer
1	0	MARB is held fixed
	1	Decremented: If DTSZ = 0, MARB is decremented by 1 after each transfer If DTSZ = 1, MARB is decremented by 2 after each transfer

MAR1A R/E/H/L—Memory Address Register 1A R/E/H/L	H'FFF30 H'FFF31 H'FFF32 H'FFF33	DMAC1



Note: Bit functions are the same as for DMAC0.

ETCR1A H/L—Execute Transfer Count Register 1A H/L	H'FFF34 H'FFF35	DMAC1



Note: Bit functions are the same as for DMAC0.

IOAR1A—I/O Address Register 1A	H'FFF36	DMAC1

Bit	7	6	5	4	3	2	1	0
Initial value	Undetermined							
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Note: Bit functions are the same as for DMAC0.

DTCR1A—Data Transfer Control Register 1A	H'FFF37	DMAC1

- Short address mode

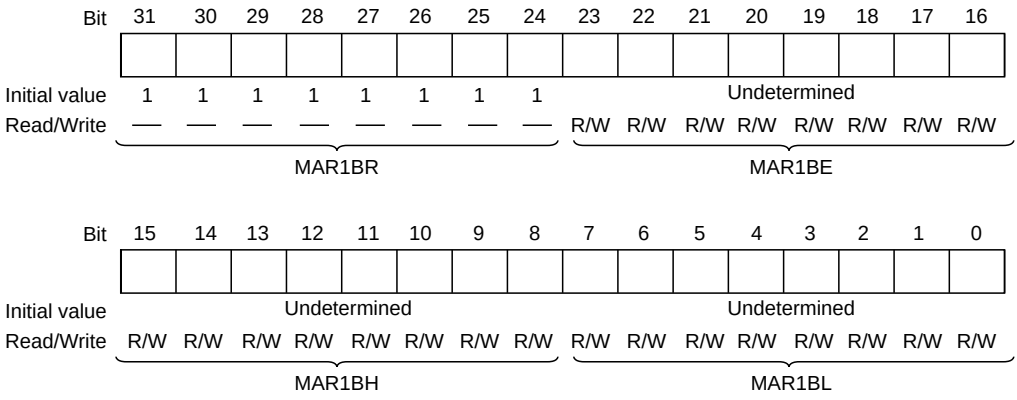
Bit	7	6	5	4	3	2	1	0
	DTE	DTSZ	DTID	RPE	DTIE	DTS2	DTS1	DTS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

- Full address mode

Bit	7	6	5	4	3	2	1	0
	DTE	DTSZ	SAID	SAIDE	DTIE	DTS2A	DTS1A	DTS0A
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

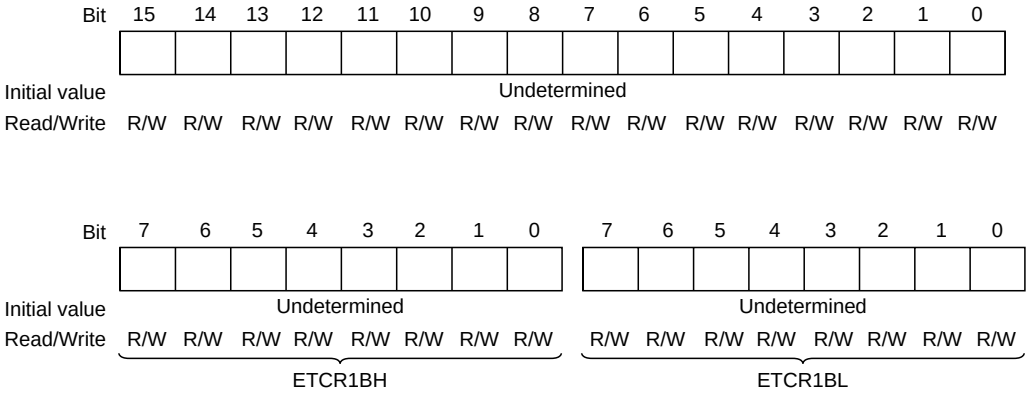
Note: Bit functions are the same as for DMAC0.

MAR1B R/E/H/L—Memory Address Register 1B R/E/H/L	H'FFF38 H'FFF39 H'FFF3A H'FFF3B	DMAC1



Note: Bit functions are the same as for DMAC0.

ETCR1B H/L—Execute Transfer Count Register 1B H/L	H'FFF3C H'FFF3D	DMAC1



Note: Bit functions are the same as for DMAC0.

IOAR1B—I/O Address Register 1B	H'FFF3E	DMAC1

Bit	7	6	5	4	3	2	1	0
Initial value	Undetermined							
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Note: Bit functions are the same as for DMAC0.

DTCR1B—Data Transfer Control Register 1B	H'FFF3F	DMAC1

- Short address mode

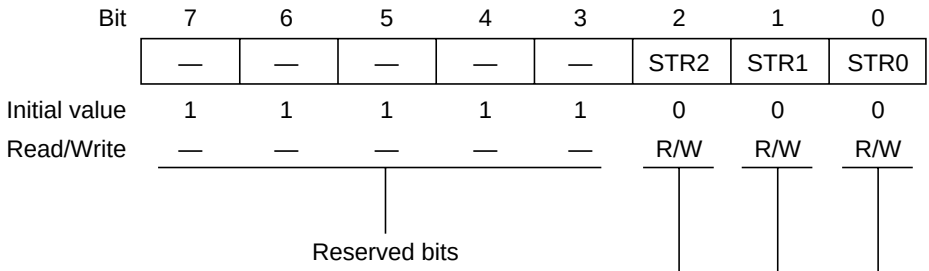
Bit	7	6	5	4	3	2	1	0
	DTE	DTSZ	DTID	RPE	DTIE	DTS2	DTS1	DTS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

- Full address mode

Bit	7	6	5	4	3	2	1	0
	DTME	———	DAID	DAIDE	TMS	DTS2B	DTS1B	DTS0B
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Note: Bit functions are the same as for DMAC0.

TSTR—Timer Start Register	H'FFF60	16-bit timer (all channels)



Counter start 0

0	TCNT0 is halted	(Initial value)
1	TCNT0 is counting	

Counter start 1

0	TCNT1 is halted	(Initial value)
1	TCNT1 is counting	

Counter start 2

0	TCNT2 is halted	(Initial value)
1	TCNT2 is counting	

TSNC—Timer Synchro Register	H'FFF61	16-bit timer (all channels)

Bit	7	6	5	4	3	2	1	0
	—	—	—	—	—	SYNC2	SYNC1	SYNC0
Initial value	1	1	1	1	1	0	0	0
Read/Write	—	—	—	—	—	R/W	R/W	R/W

Reserved bits

Timer synchronization 0

0	Channel 0 timer counter (TCNT0) operates independently (TCNT0 presetting/clearing is unrelated to other channels) (Initial value)
1	Channel 0 operates synchronously TCNT0 synchronous presetting/synchronous clearing is possible

Timer synchronization 1

0	Channel 1 timer counter (TCNT1) operates independently (TCNT1 presetting/clearing is unrelated to other channels) (Initial value)
1	Channel 1 operates synchronously TCNT1 synchronous presetting/synchronous clearing is possible

Timer synchronization 2

0	Channel 2 timer counter (TCNT2) operates independently (TCNT2 presetting/clearing is unrelated to other channels) (Initial value)
1	Channel 2 operates synchronously TCNT2 synchronous presetting/synchronous clearing is possible

TMDR—Timer Mode Register	H'FFF62	16-bit timer (all channels)

Bit	7	6	5	4	3	2	1	0
	—	MDF	FDIR	—	—	PWM2	PWM1	PWM0
Initial value	1	0	0	1	1	0	0	0
Read/Write	—	R/W	R/W	—	—	R/W	R/W	R/W

PWM mode 0

0	Channel 0 operates normally (Initial value)
1	Channel 0 operates in PWM mode

PWM mode 1

0	Channel 1 operates normally (Initial value)
1	Channel 1 operates in PWM mode

PWM mode 2

0	Channel 2 operates normally (Initial value)
1	Channel 2 operates in PWM mode

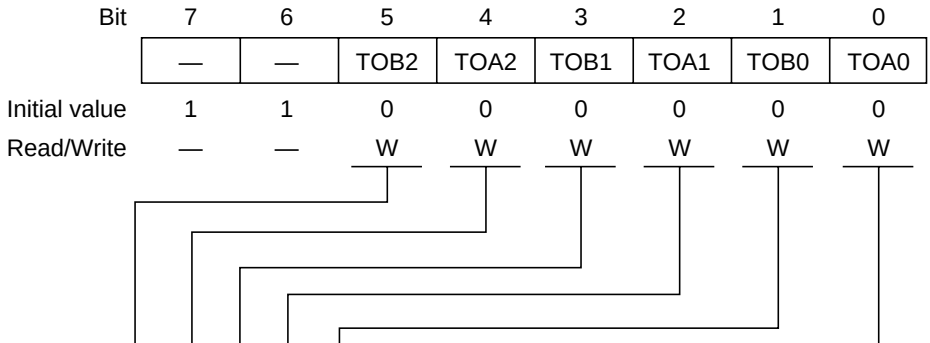
Flag direction

0	OVF is set to 1 in TISRC when TCNT2 overflows or underflows (Initial value)
1	OVF is set to 1 in TISRC when TCNT2 overflows

Phase counting mode flag

0	Channel 2 operates normally (Initial value)
1	Channel 2 operates in phase counting mode

TOLR—Timer Output Level Setting Register	H'FFF63	16-bit timer (all channels)



Bit	7	6	5	4	3	2	1	0
	—	—	TOB2	TOA2	TOB1	TOA1	TOB0	TOA0
Initial value	1	1	0	0	0	0	0	0
Read/Write	—	—	W	W	W	W	W	W

Output level setting A0

0	$TIOCA_0$ is 0	(Initial value)
1	$TIOCA_0$ is 1	

Output level setting B0

0	$TIOCB_0$ is 0	(Initial value)
1	$TIOCB_0$ is 1	

Output level setting A1

0	$TIOCA_1$ is 0	(Initial value)
1	$TIOCA_1$ is 1	

Output level setting B1

0	$TIOCB_1$ is 0	(Initial value)
1	$TIOCB_1$ is 1	

Output level setting A2

0	$TIOCA_2$ is 0	(Initial value)
1	$TIOCA_2$ is 1	

Output level setting B2

0	$TIOCB_2$ is 0	(Initial value)
1	$TIOCB_2$ is 1	

Bit:	7	6	5	4	3	2	1	0
	—	IMIEA2	IMIEA1	IMIEA0	—	IMFA2	IMFA1	IMFA0
Initial value:	1	0	0	0	1	0	0	0
Read/Write:	—	R/W	R/W	R/W	—	R/(W)*	R/(W)*	R/(W)*

Input capture/compare match flag A0

0	[Clearing conditions] (Initial value) Read IMFA0 when IMFA0=1, then write 0 in IMFA0 DMAC activated by IMIA0 interrupt.
1	[Setting conditions] TCNT0=GRA0 when GRA0 functions as an output compare register. TCNT0 value is transferred to GRA0 by an input capture signal when GRA0 functions as an input capture register.

Input capture/compare match flag A1

0	[Clearing conditions] (Initial value) Read IMFA1 when IMFA1=1, then write 0 in IMFA1 DMAC activated by IMIA1 interrupt.
1	[Setting conditions] TCNT1=GRA1 when GRA1 functions as an output compare register. TCNT1 value is transferred to GRA1 by an input capture signal when GRA1 functions as an input capture register.

Input capture/compare match flag A2

0	[Clearing conditions] (Initial value) Read IMFA2 when IMFA2=1, then write 0 in IMFA2 DMAC activated by IMIA2 interrupt.
1	[Setting conditions] TCNT2=GRA2 when GRA2 functions as an output compare register. TCNT2 value is transferred to GRA2 by an input capture signal when GRA2 functions as an input capture register.

Input capture/compare match interrupt enable A0

0	IMIA0 interrupt requested by IMFA0 flag is disabled	(Initial value)
1	IMIA0 interrupt requested by IMFA0 flag is enabled	

Input capture/compare match interrupt enable A1

0	IMIA1 interrupt requested by IMFA1 flag is disabled	(Initial value)
1	IMIA1 interrupt requested by IMFA1 flag is enabled	

Input capture/compare match interrupt enable A2

0	IMIA2 interrupt requested by IMFA2 flag is disabled	(Initial value)
1	IMIA2 interrupt requested by IMFA2 flag is enabled	

Note: * Only 0 can be written, to clear the flag.

Bit:	7	6	5	4	3	2	1	0
	—	IMIEB2	IMIEB1	IMIEB0	—	IMFB2	IMFB1	IMFB0
Initial value:	1	0	0	0	1	0	0	0
Read/Write:	—	R/W	R/W	R/W	—	R/(W)*	R/(W)*	R/(W)*

Input capture/compare match flag B0

0	[Clearing condition] (Initial value) Read IMFB0 when IMFB0=1, then write 0 in IMFB0.
1	[Setting conditions] TCNT0=GRB0 when GRB0 functions as an output compare register. TCNT0 value is transferred to GRB0 by an input capture signal when GRB0 functions as an input capture register.

Input capture/compare match flag B1

0	[Clearing condition] (Initial value) Read IMFB1 when IMFB1=1, then write 0 in IMFB1.
1	[Setting conditions] TCNT1=GRB1 when GRB1 functions as an output compare register. TCNT1 value is transferred to GRB1 by an input capture signal when GRB1 functions as an input capture register.

Input capture/compare match flag B2

0	[Clearing condition] (Initial value) Read IMFB2 when IMFB2=1, then write 0 in IMFB2.
1	[Setting conditions] TCNT2=GRB2 when GRB2 functions as an output compare register. TCNT2 value is transferred to GRB2 by an input capture signal when GRB2 functions as an input capture register.

Input capture/compare match interrupt enable B0

0	IMIB0 interrupt requested by IMFB0 flag is disabled	(Initial value)
1	IMIB0 interrupt requested by IMFB0 flag is enabled	

Input capture/compare match interrupt enable B1

0	IMIB1 interrupt requested by IMFB1 flag is disabled	(Initial value)
1	IMIB1 interrupt requested by IMFB1 flag is enabled	

Input capture/compare match interrupt enable B2

0	IMIB2 interrupt requested by IMFB2 flag is disabled	(Initial value)
1	IMIB2 interrupt requested by IMFB2 flag is enabled	

Note : * Only 0 can be written, to clear the flag.

TISRC—Timer Interrupt Status Register C	H'FFF66	16-bit timer (all channels)

Bit:	7	6	5	4	3	2	1	0
	—	OVIE2	OVIE1	OVIE0	—	OVF2	OVF1	OVF0
Initial value:	1	0	0	0	1	0	0	0
Read/Write:	—	R/W	R/W	R/W	—	R/(W)*	R/(W)*	R/(W)*

Overflow flag 0

0	[Clearing condition] (Initial value) Read OVF0 when OVF0 = 1, then write 0 in OVF0.
1	[Setting condition] TCNT0 overflowed from H'FFFF to H'0000.

Overflow flag 1

0	[Clearing condition] (Initial value) Read OVF1 when OVF1 = 1, then write 0 in OVF1.
1	[Setting condition] TCNT1 overflowed from H'FFFF to H'0000.

Overflow flag 2

0	[Clearing condition] (Initial value) Read OVF2 when OVF2 = 1, then write 0 in OVF2.
1	[Setting condition] TCNT2 overflowed from H'FFFF to H'0000, or underflowed from H'0000 to H'FFFF.

Overflow interrupt enable 0

0	OVI0 interrupt requested by OVF0 flag is disabled	(Initial value)
1	OVI0 interrupt requested by OVF0 flag is enabled	

Overflow interrupt enable 1

0	OVI1 interrupt requested by OVF1 flag is disabled	(Initial value)
1	OVI1 interrupt requested by OVF1 flag is enabled	

Overflow interrupt enable 2

0	OVI2 interrupt requested by OVF2 flag is disabled	(Initial value)
1	OVI2 interrupt requested by OVF2 flag is enabled	

Note : * Only 0 can be written, to clear the flag.

16TCR0—Timer Control Register	H'FFF68	16-bit timer channel 0

Bit	7	6	5	4	3	2	1	0
	—	CCLR1	CCLR0	CKEG1	CKEG0	TPSC2	TPSC1	TPSC0
Initial value	1	0	0	0	0	0	0	0
Read/Write	—	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Timer prescaler 2 to 0

Bit 2	Bit 1	Bit 0	TCNT Clock Source
TPSC2	TPSC1	TPSC0	
0	0	0	Internal clock : φ (Initial value)
		1	Internal clock : φ / 2
	1	0	Internal clock : φ / 4
		1	Internal clock : φ / 8
1	0	0	External clock A : TCLKA input
		1	External clock B : TCLKB input
	1	0	External clock C : TCLKC input
		1	External clock D : TCLKD input

Clock edge 1 and 0

Bit 4	Bit 3	Counted Edges of External Clock
CKEG1	CKEG0	
0	0	Rising edges counted (Initial value)
0	1	Falling edges counted
1	—	Both edges counted

Counter clear 1 and 0

Bit 6	Bit 5	TCNT clear Sources
CCLR1	CCLR0	
0	0	TCNT is not cleared (Initial value)
	1	TCNT is cleared by GRA compare match or input capture
1	0	TCNT is cleared by GRB compare match or input capture
	1	Synchronous clear : TCNT is cleared in synchronization with other synchronized timers

Bit:	7	6	5	4	3	2	1	0
	—	IOB2	IOB1	IOB0	—	IOA2	IOA1	IOA0
Initial value:	1	0	0	0	1	0	0	0
Read/Write:	—	R/W	R/W	R/W	—	R/W	R/W	R/W

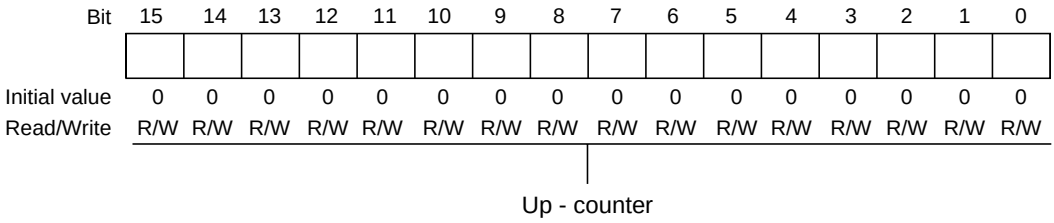
I/O control A2 to A0

Bit 2	Bit 1	Bit 0	GRA Functions	
IOA2	IOA1	IOA0		
0	0	0	GRA is an output compare register	No output at compare match (Initial value)
		1		0 output at GRA compare match
	1	0		1 output at GRA compare match
		1		Output toggles at GRA compare match (channel 2 only: 1 output)
1	0	0	GRA is an input capture register	GRA captures rising edges of input
		1		GRA captures falling edges of input
	1	0		GRA captures both edges of input
		1		

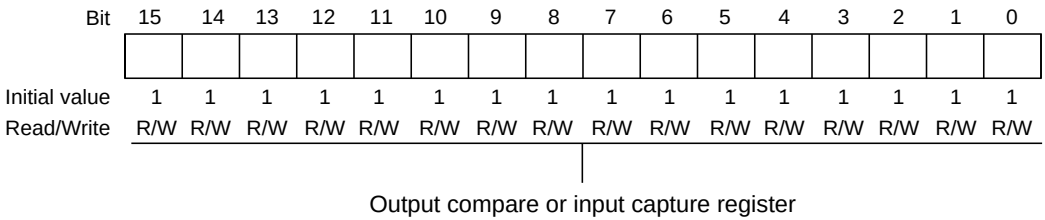
I/O control B2 to B0

Bit 6	Bit 5	Bit 4	GRB Functions	
IOB2	IOB1	IOB0		
0	0	0	GRB is an output compare register	No output at compare match (Initial value)
		1		0 output at GRB compare match
	1	0		1 output at GRB compare match
		1		Output toggles at GRB compare match (channel 2 only: 1 output)
1	0	0	GRB is an input capture register	GRB captures rising edges of input
		1		GRB captures falling edges of input
	1	0		GRB captures both edges of input
		1		

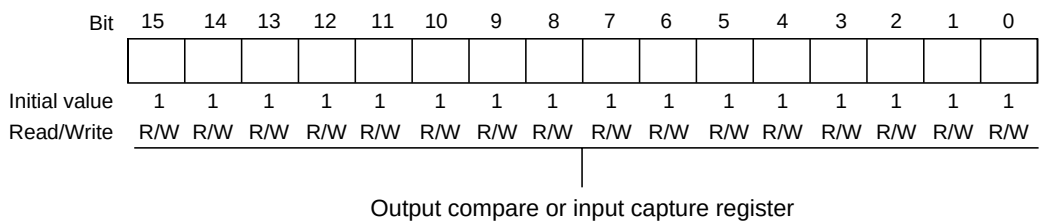
16TCNT0 H/L—Timer Counter 0 H/L	H'FFF6A, H'FFF6B	16-bit timer channel 0



GRA0 H/L—General Register A0 H/L	H'FFF6C, H'FFF6D	16-bit timer channel 0



GRB0 H/L—General Register B0 H/L	H'FFF6E, H'FFF6F	16-bit timer channel 0



16TCR1 Timer Control Register 1	H'FFF70	16-bit timer channel 1

Bit	7	6	5	4	3	2	1	0
	—	CCLR1	CCLR0	CKEG1	CKEG0	TPSC2	TPSC1	TPSC0
Initial value	1	0	0	0	0	0	0	0
Read/Write	—	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Note: Bit functions are the same as for 16-bit timer channel 0.

TIOR1—Timer I/O Control Register 1	H'FFF71	16-bit timer channel 1

Bit	7	6	5	4	3	2	1	0
	—	IOB2	IOB1	IOB0	—	IOA2	IOA1	IOA0
Initial value	1	0	0	0	1	0	0	0
Read/Write	—	R/W	R/W	R/W	—	R/W	R/W	R/W

Note: Bit functions are the same as for 16-bit timer channel 0.

16TCNT1 H/L—Timer Counter 1 H/L	H'FFF72, H'FFF73	16-bit timer channel 1

Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Initial value	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Note: Bit functions are the same as for 16-bit timer channel 0.

GRA1 H/L—General Register A1 H/L	H'FFF74, H'FFF75	16-bit timer channel 1

Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Initial value	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Note: Bit functions are the same as for 16-bit timer channel 0.

GRB1 H/L—General Register B1 H/L	H'FFF76, H'FFF77	16-bit timer channel 1

Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Initial value	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Note: Bit functions are the same as for 16-bit timer channel 0.

16TCR2 Timer Control Register 2	H'FFF78	16-bit timer channel 2

Bit	7	6	5	4	3	2	1	0
	—	CCLR1	CCLR0	CKEG1	CKEG0	TPSC2	TPSC1	TPSC0
Initial value	1	0	0	0	0	0	0	0
Read/Write	—	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Notes : 1. Bit functions are the same as for 16-bit timer channel 0.
2. When phase counting mode is selected in channel 2, the settings of bits CKEG1 and CKEG0 and TPSC2 to TPSC0 in TCR2 are ignored.

TIOR2—Timer I/O Control Register 2	H'FFF79	16-bit timer channel 2

Bit	7	6	5	4	3	2	1	0
	—	IOB2	IOB1	IOB0	—	IOA2	IOA1	IOA0
Initial value	1	0	0	0	1	0	0	0
Read/Write	—	R/W	R/W	R/W	—	R/W	R/W	R/W

Note: Bit functions are the same as for 16-bit timer channel 0.

16TCNT2 H/L—Timer Counter 2 H/L	H'FFF7A, H'FFF7B	16-bit timer channel 2

Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Initial value	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Phase counting mode : up/down counter
Other mode : up-counter

GRA2 H/L—General Register A2 H/L	H'FFF7C, H'FFF7D	16-bit timer channel 2

Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Initial value	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Note: Bit functions are the same as for 16-bit timer channel 0.

GRB2 H/L—General Register B2 H/L	H'FFF7E, H'FFF7F	16-bit timer channel 2

Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Initial value	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Note: Bit functions are the same as for 16-bit timer channel 0.

Bit	7	6	5	4	3	2	1	0
	CMIEB	CMIEA	OVIE	CCLR1	CCLR0	CKS2	CKS1	CKS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Clock select 2 to 0

0	0	0	Clock input is disabled
		1	Internal clock, counted on rising edge of φ/8
	1	0	Internal clock, counted on rising edge of φ/64
		1	Internal clock, counted on rising edge of φ/8192
1	0	0	Channel 0: Count on TCNT1 overflow signal* Channel 1: Count on TCNT0 compare match A*
		1	External clock, counted on falling edge
	1	0	External clock, counted on rising edge
		1	External clock, counted on both rising and falling edges

Notes: * If the clock input of channel 0 is the TCNT1 overflow signal and that of channel 1 is the TCNT0 compare match signal, no incrementing clock is generated. Do not use this setting.

Counter clear 1 and 0

0	0	Clearing is disabled
	1	Cleared by compare match A
1	0	Cleared by compare match B/input capture B
	1	Cleared by input capture B

Timer overflow interrupt enable

0	OVI interrupt requested by OVF is disabled
1	OVI interrupt requested by OVF is enabled

Compare match interrupt enable A

0	CMIA interrupt requested by CMFA is disabled
1	CMIA interrupt requested by CMFA is enabled

Compare match interrupt enable B

0	CMIB interrupt requested by CMFB is disabled
1	CMIB interrupt requested by CMFB is enabled

Bit	7	6	5	4	3	2	1	0
	CMFB	CMFA	OVF	ADTE	OIS3	OIS2	OS1	OS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/(W)*	R/(W)*	R/(W)*	R/W	R/W	R/W	R/W	R/W

Output select A1 and A0

Bit 1	Bit 0	Description
OS1	OS0	
0	0	No change at compare match A
	1	0 output at compare match A
1	0	1 output at compare match A
	1	Output toggles at compare match A

Output/input capture edge select B3 and B2

ICE in TCSR1	Bit 3 OIS3	Bit 2 OIS2	Description
0	0	0	No change at compare match B
		1	0 output at compare match B
	1	0	1 output at compare match B
		1	Output toggles at compare match B
1	0	0	TCORB input capture on rising edge
		1	TCORB input capture on falling edge
	1	0	TCORB input capture on both rising and falling edges
		1	

A/D trigger enable (TCSR0 only)

TRGE*1	Bit 4 ADTE	Description
0	0	A/D converter start requests by compare match A or an external trigger are disabled
	1	A/D converter start requests by compare match A or an external trigger are enabled
1	0	A/D converter start requests by an external trigger are enabled
	1	A/D converter start requests by compare match A are enabled

Note: *1 TRGE is bit 7 of the A/D control register (ADCR).

Timer overflow flag

0	[Clearing condition] Read OVF when OVF = 1, then write 0 in OVF
1	[Setting condition] TCNT overflows from H'FF to H'00

Compare match flag A

0	[Clearing condition] Read CMFA when CMFA = 1, then write 0 in CMFA
1	[Setting condition] TCNT = TCORA

Compare match/input capture flag B

0	[Clearing condition] Read CMFB when CMFB = 1, then write 0 in CMFB
1	[Setting conditions] TCNT = TCORB The TCNT value is transferred to TCORB by an input capture signal when TCORB functions as an input capture register.

Note: * Only 0 can be written to bits 7 to 5, to clear these flags.

Bit	7	6	5	4	3	2	1	0
	CMFB	CMFA	OVF	ICE	OIS3	OIS2	OS1	OS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/(W)*	R/(W)*	R/(W)*	R/W	R/W	R/W	R/W	R/W

Output select A1 and A0

Bit 1	Bit 0	Description
OS1	OS0	
0	0	No change at compare match A
	1	0 output at compare match A
1	0	1 output at compare match A
	1	Output toggles at compare match A

Output/input capture edge select B3 and B2

ICE in TCSR1	Bit 3	Bit 2	Description
	OIS3	OIS2	
0	0	0	No change at compare match B
		1	0 output at compare match B
	1	0	1 output at compare match B
		1	Output toggles at compare match B
1	0	0	TCORB input capture on rising edge
		1	TCORB input capture on falling edge
	1	0	TCORB input capture on both rising and falling edges
		1	

Input capture enable

0	TCORB is a compare match register
1	TCORB is an input capture register

Timer overflow flag

0	[Clearing condition] Read OVF when OVF = 1, then write 0 in OVF
1	[Setting condition] TCNT overflows from H'FF to H'00

Compare match flag A

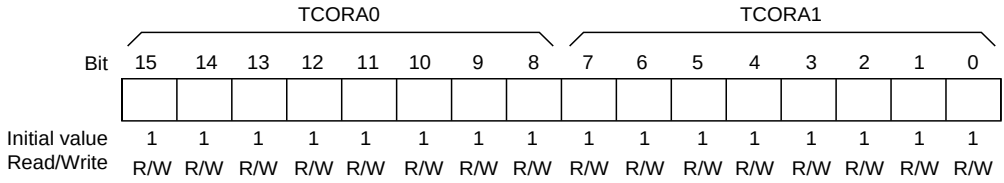
0	[Clearing condition] Read CMFA when CMFA = 1, then write 0 in CMFA
1	[Setting condition] TCNT = TCORA

Compare match/input capture flag B

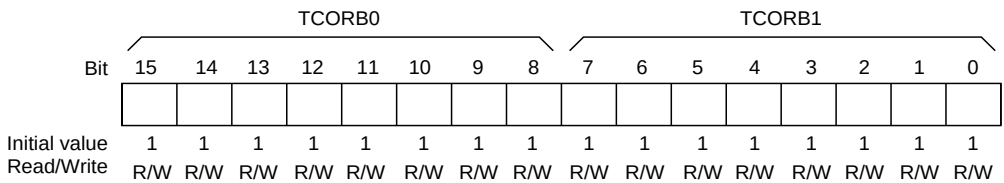
0	[Clearing condition] Read CMFB when CMFB = 1, then write 0 in CMFB
1	[Setting conditions] TCNT = TCORB The TCNT value is transferred to TCORB by an input capture signal when TCORB functions as an input capture register.

Note: * Only 0 can be written to bits 7 to 5, to clear these flags.

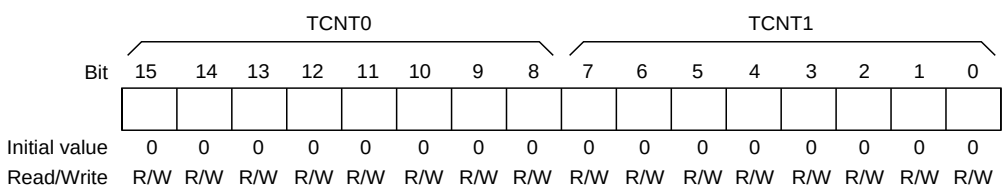
TCORA0—Time Constant Register A0 TCORA1—Time Constant Register A1	H'FFF84 H'FFF85	8-bit timer channel 0 8-bit timer channel 1



TCORB0—Time Constant Register B0 TCORB1—Time Constant Register B1	H'FFF86 H'FFF87	8-bit timer channel 0 8-bit timer channel 1



8TCNT0—Timer Counter 0 8TCNT1—Timer Counter 1	H'FFF88 H'FFF89	8-bit timer channel 0 8-bit timer channel 1



Bit	7	6	5	4	3	2	1	0
	OVF	WT/$\overline{IT}$	TME	———	———	CKS2	CKS1	CKS0
Initial value	0	0	0	1	1	0	0	0
Read/Write	R/(W)*	R/W	R/W	—	—	R/W	R/W	R/W

Clock select 2 to 0

CKS2	CKS1	CKS0	Description
0	0	0	ϕ/2
		1	ϕ/32
	1	0	ϕ/64
		1	ϕ/128
1	0	0	ϕ/256
		1	ϕ/512
	1	0	ϕ/2048
		1	ϕ/4096

Timer enable

0	Timer disabled • TCNT is initialized to H'00 and halted
1	Timer enabled • TCNT is counting

Timer mode select

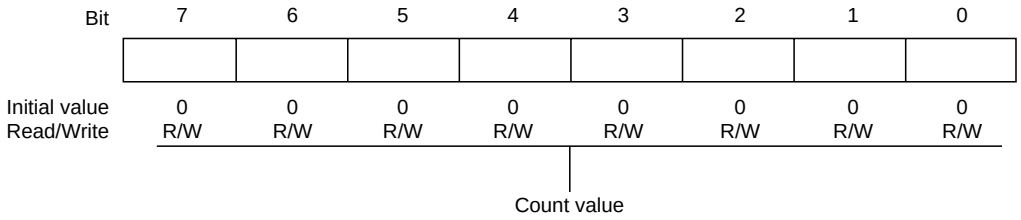
0	Interval timer: requests interval timer interrupts
1	Watchdog timer: generates a reset signal

Overflow flag

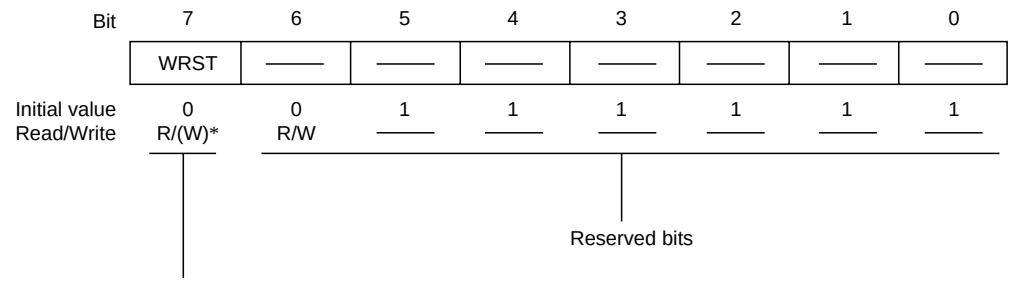
0	[Clearing condition] Read OVF when OVF = 1, then write 0 in OVF
1	[Setting condition] TCNT changes from H'FF to H'00

Note: * Only 0 can be written, to clear the flag.

TCNT—Timer Counter	H'FFF8D (read), H'FFF8C (write)	WDT



RSTCSR—Reset Control/Status Register	H'FFF8F (read), H'FFF8E (write)	WDT



0	[Clearing conditions] Reset signal at $\overline{\text{RES}}$ pin Read WRST when WRST = 1, then write 0 in WRST
1	[Setting condition] TCNT overflow generates a reset signal

Note: * Only 0 can be written in bit 7, to clear the flag.

Bit	7	6	5	4	3	2	1	0
	CMIEB	CMIEA	OVIE	CCLR1	CCLR0	CKS2	CKS1	CKS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Clock select 2 to 0

CSK2	CSK1	CSK0	Description
0	0	0	Clock input is disabled
		1	Internal clock, counted on rising edge of ϕ/8
	1	0	Internal clock, counted on rising edge of ϕ/64
		1	Internal clock, counted on rising edge of ϕ/8192
1	0	0	Channel 2: Count on TCNT3 overflow signal* Channel 3: Count on TCNT2 compare match A*
		1	External clock, counted on falling edge
	1	0	External clock, counted on rising edge
		1	External clock, counted on both rising and falling edges

Note: * If the clock input of channel 2 is the TCNT3 overflow signal and that of channel 3 is the TCNT2 compare match signal, no incrementing clock is generated. Do not use this setting.

Counter clear 1 and 0

0	0	Clearing is disabled
	1	Cleared by compare match A
1	0	Cleared by compare match B/input capture B
	1	Cleared by input capture B

Timer overflow interrupt enable

0	OVI interrupt requested by OVF is disabled
1	OVI interrupt requested by OVF is enabled

Compare match interrupt enable A

0	CMIA interrupt requested by CMFA is disabled
1	CMIA interrupt requested by CMFA is enabled

Compare match interrupt enable B

0	CMIB interrupt requested by CMFB is disabled
1	CMIB interrupt requested by CMFB is enabled

TCSR2	Bit	7	6	5	4	3	2	1	0
		CMFB	CMFA	OVF	—	OIS3	OIS2	OS1	OS0
	Initial value	0	0	0	1	0	0	0	0
	Read/Write	R/(W)*	R/(W)*	R/(W)*	—	R/W	R/W	R/W	R/W

TCSR3	Bit	7	6	5	4	3	2	1	0
		CMFB	CMFA	OVF	ICE	OIS3	OIS2	OS1	OS0
	Initial value	0	0	0	0	0	0	0	0
	Read/Write	R/(W)*	R/(W)*	R/(W)*	R/W	R/W	R/W	R/W	R/W

Output select A1 and A0

Bit 1	Bit 0	Description
OS1	OS0	
0	0	No change at compare match A
	1	0 output at compare match A
1	0	1 output at compare match A
	1	Output toggles at compare match A

Output/input capture edge select B3 and B2

ICE in TCSR3	Bit 3 OIS3	Bit 3 OIS2	Description
0	0	0	No change at compare match B
		1	0 output at compare match B
	1	0	1 output at compare match B
		1	Output toggles at compare match B
1	0	0	TCORB input capture on rising edge
		1	TCORB input capture on falling edge
	1	0	TCORB input capture on both rising and falling edges

Input capture enable (TCSR3 only)

0	TCORB is a compare match register
1	TCORB is an input capture register

Timer overflow flag

0	[Clearing condition] Read OVF when OVF = 1, then write 0 in OVF
1	[Setting condition] TCNT overflows from H'FF to H'00

Compare match flag A

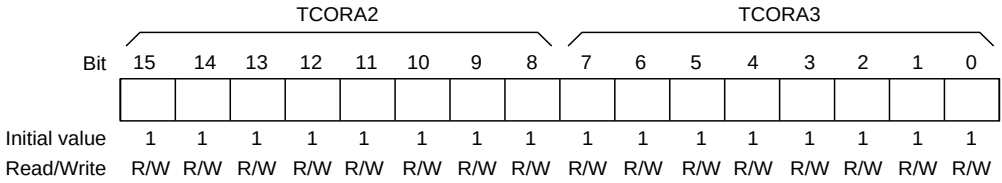
0	[Clearing condition] Read CMFA when CMFA = 1, then write 0 in CMFA
1	[Setting condition] TCNT = TCORA

Compare match/input capture flag B

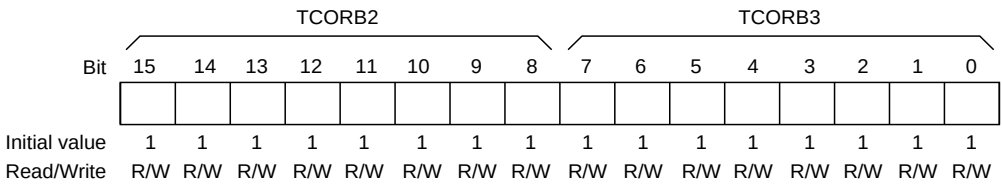
0	[Clearing condition] Read CMFB when CMFB = 1, then write 0 in CMFB
1	[Setting conditions] TCNT = TCORB The TCNT value is transferred to TCORB by an input capture signal when TCORB functions as an input capture register.

Note: * Only 0 can be written to bits 7 to 5, to clear these flags.

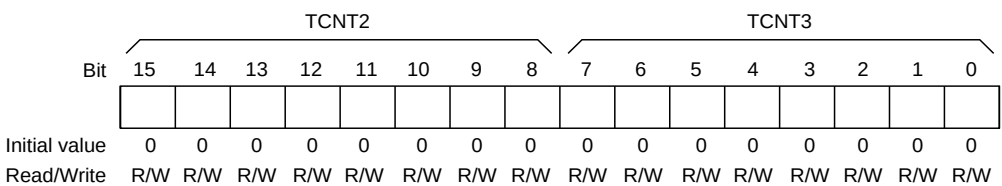
TCORA2—Time Constant Register A2 TCORA3—Time Constant Register A3	H'FFF94 H'FFF95	8-bit timer channel 2 8-bit timer channel 3



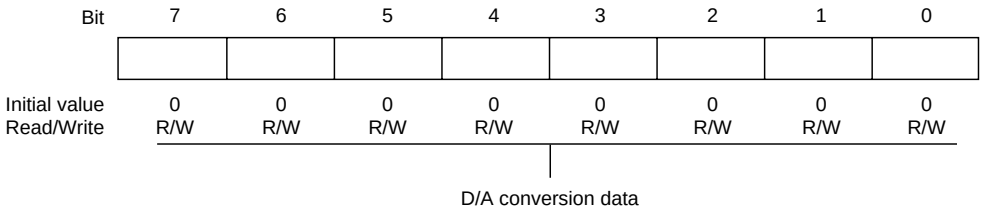
TCORB2—Time Constant Register B2 TCORB3—Time Constant Register B3	H'FFF96 H'FFF97	8-bit timer channel 2 8-bit timer channel 3



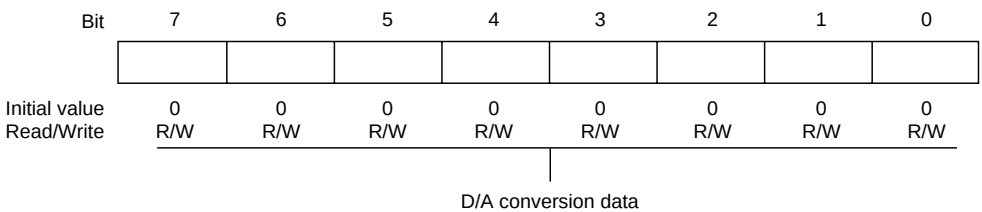
8TCNT2—Timer Counter 2 8TCNT3—Timer Counter 3	H'FFF98 H'FFF99	8-bit timer channel 2 8-bit timer channel 3



DADR0—D/A Data Register 0	H'FFF9C	D/A



DADR1—D/A Data Register 1	H'FFF9D	D/A



Bit	7	6	5	4	3	2	1	0
	DAOE1	DAOE0	DAE	—	—	—	—	—
Initial value	0	0	0	1	1	1	1	1
Read/Write	R/W	R/W	R/W	—	—	—	—	—

D/A enable

Bit 7	Bit 6	Bit 5	Description
DAOE1	DAOE0	DAE	
0	0	—	D/A conversion is disabled in channels 0 and 1
0	1	0	D/A conversion is enabled in channel 0 D/A conversion is disabled in channel 1
0	1	1	D/A conversion is enabled in channels 0 and 1
1	0	0	D/A conversion is disabled in channel 0 D/A conversion is enabled in channel 1
1	0	1	D/A conversion is enabled in channels 0 and 1
1	1	—	D/A conversion is enabled in channels 0 and 1

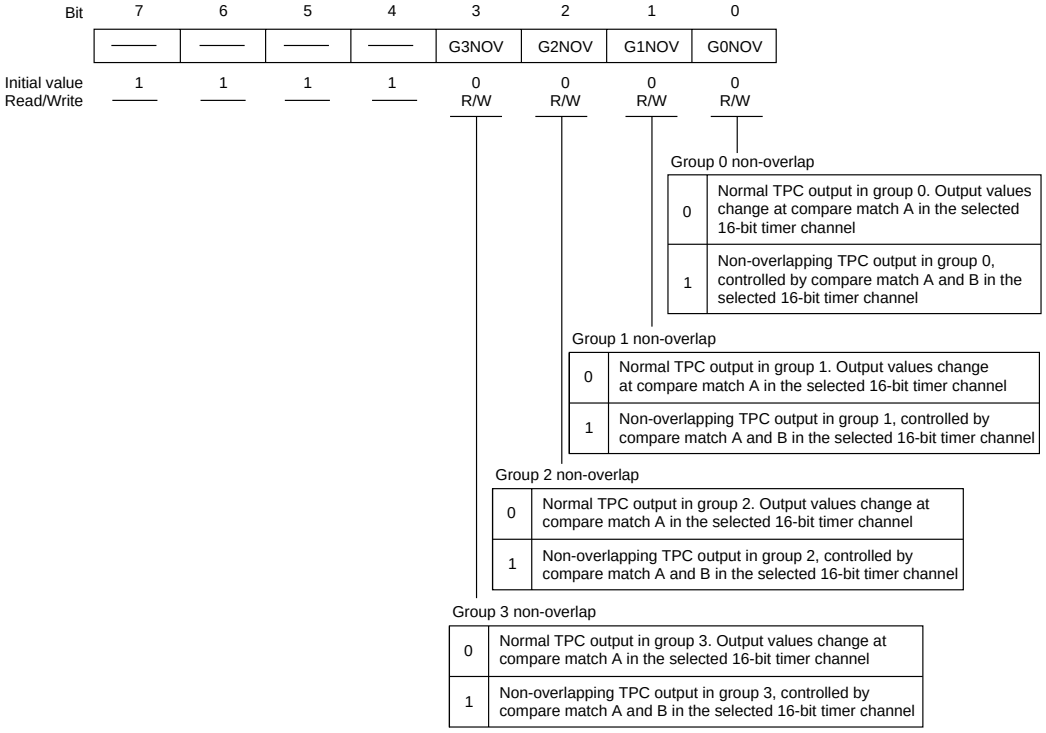
D/A output enable 0

0	DA_0 analog output is disabled
1	Channel-0 D/A conversion and DA_0 analog output are enabled

D/A output enable 1

0	DA_1 analog output is disabled
1	Channel-1 D/A conversion and DA_1 analog output are enabled

TPMR—TPC Output Mode Register	H'FFFA0	TPC



Bit	7	6	5	4	3	2	1	0
	G3CMS1	G3CMS0	G2CMS1	G2CMS0	G1CMS1	G1CMS0	G0CMS1	G0CMS0
Initial value	1	1	1	1	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Group 0 compare match select 1 and 0

Bit 1	Bit 0	16-Bit Timer Channel Selected as Output Trigger
G0CMS1	G0CMS0	
0	0	TPC output group 0 (TP_3 to TP_0) is triggered by compare match in 16-bit timer channel 0
	1	TPC output group 0 (TP_3 to TP_0) is triggered by compare match in 16-bit timer channel 1
1	0	TPC output group 0 (TP_3 to TP_0) is triggered by compare match in 16-bit timer channel 2
	1	

Group 1 compare match select 1 and 0

Bit 3	Bit 2	16-Bit Timer Channel Selected as Output Trigger
G1CMS1	G1CMS0	
0	0	TPC output group 1 (TP_7 to TP_4) is triggered by compare match in 16-bit timer channel 0
	1	TPC output group 1 (TP_7 to TP_4) is triggered by compare match in 16-bit timer channel 1
1	0	TPC output group 1 (TP_7 to TP_4) is triggered by compare match in 16-bit timer channel 2
	1	

Group 2 compare match select 1 and 0

Bit 5	Bit 4	16-Bit Timer Channel Selected as Output Trigger
G2CMS1	G2CMS0	
0	0	TPC output group 2 (TP_{11} to TP_8) is triggered by compare match in 16-bit timer channel 0
	1	TPC output group 2 (TP_{11} to TP_8) is triggered by compare match in 16-bit timer channel 1
1	0	TPC output group 2 (TP_{11} to TP_8) is triggered by compare match in 16-bit timer channel 2
	1	

Group 3 compare match select 1 and 0

Bit 7	Bit 6	16-Bit Timer Channel Selected as Output Trigger
G3CMS1	G3CMS0	
0	0	TPC output group 3 (TP_{15} to TP_{12}) is triggered by compare match in 16-bit timer channel 0
	1	TPC output group 3 (TP_{15} to TP_{12}) is triggered by compare match in 16-bit timer channel 1
1	0	TPC output group 3 (TP_{15} to TP_{12}) is triggered by compare match in 16-bit timer channel 2
	1	

NDERB—Next Data Enable Register B

	H'FFFA2	TPC

Bit	7	6	5	4	3	2	1	0
	NDER15	NDER14	NDER13	NDER12	NDER11	NDER10	NDER9	NDER8
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Next data enable 15 to 8

Bits 7 to 0 NDER15 to NDER8	Description
0	TPC outputs TP_{15} to TP_8 are disabled (NDR15 to NDR8 are not transferred to PB_7 to PB_0)
1	TPC outputs TP_{15} to TP_8 are enabled (NDR15 to NDR8 are transferred to PB_7 to PB_0)

NDERA—Next Data Enable Register A

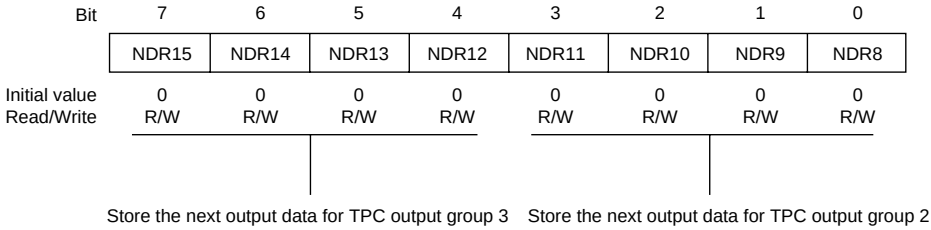
	H'FFFA3	TPC

Bit	7	6	5	4	3	2	1	0
	NDER7	NDER6	NDER5	NDER4	NDER3	NDER2	NDER1	NDER0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

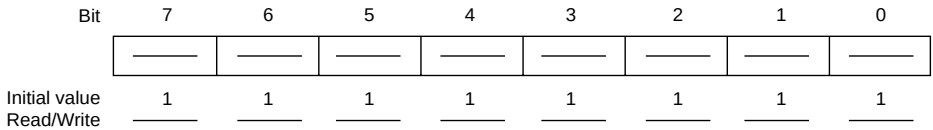
Next data enable 7 to 0

Bits 7 to 0 NDER7 to NDER0	Description
0	TPC outputs TP_7 to TP_0 are disabled (NDR7 to NDR0 are not transferred to PA_7 to PA_0)
1	TPC outputs TP_7 to TP_0 are enabled (NDR7 to NDR0 are transferred to PA_7 to PA_0)

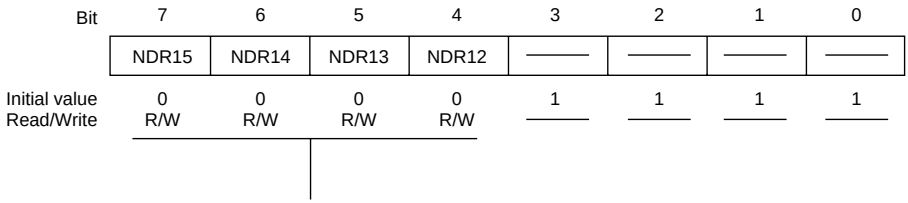
- Same trigger for TPC output groups 2 and 3
  - — Address H'FFFA4



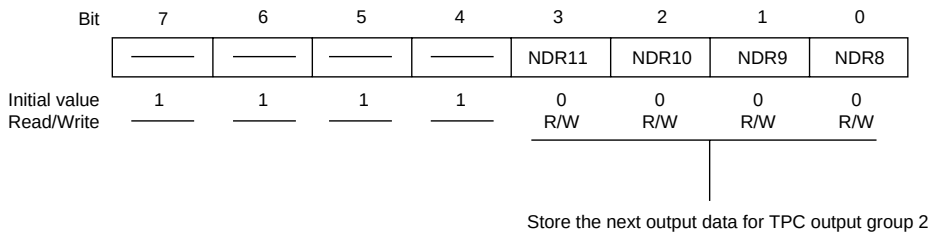
  - — Address H'FFFA6



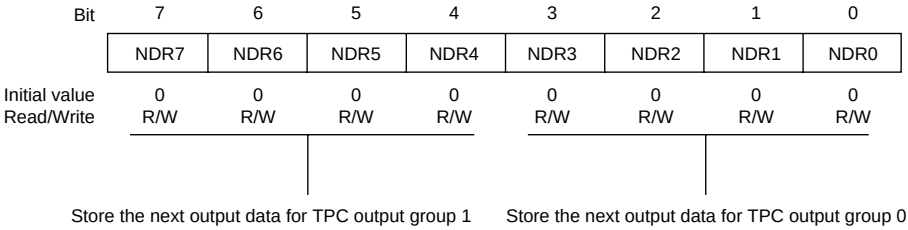
- Different triggers for TPC output groups 2 and 3
  - — Address H'FFFA4



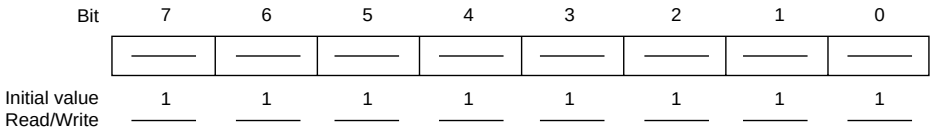
  - — Address H'FFFA6



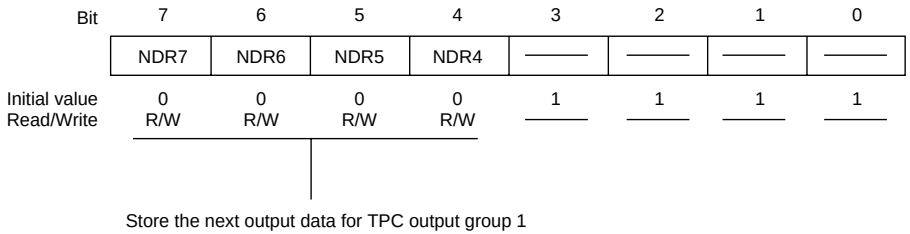
- Same trigger for TPC output groups 0 and 1
  - — Address H'FFFA5



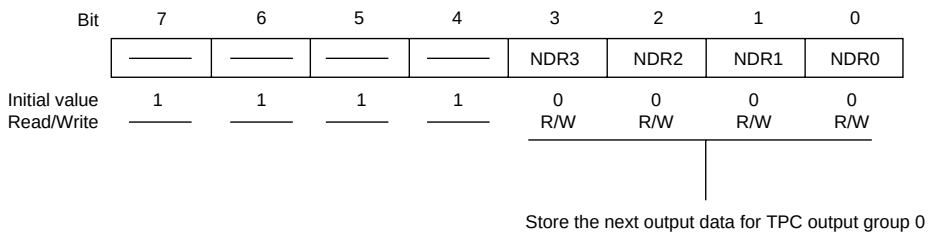
  - — Address H'FFFA7



- Different triggers for TPC output groups 0 and 1
  - — Address H'FFFA5



  - — Address H'FFFA7



Bit	7	6	5	4	3	2	1	0
	C/$\overline{A}$	CHR	PE	O/$\overline{E}$	STOP	MP	CKS1	CKS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Clock select 1 and 0

Bit 1	Bit 0	Clock Source
CKS1	CKS0	
0	0	ϕ clock
	1	ϕ/4 clock
1	0	ϕ/16 clock
	1	ϕ/64 clock

Multiprocessor mode

0	Multiprocessor function disabled
1	Multiprocessor format selected

Stop bit length

0	One stop bit
1	Two stop bits

Parity mode

0	Even parity
1	Odd parity

Parity enable

0	Parity bit is not added or checked
1	Parity bit is added and checked

Character length

0	8-bit data
1	7-bit data

Communication mode (for serial communication interface)

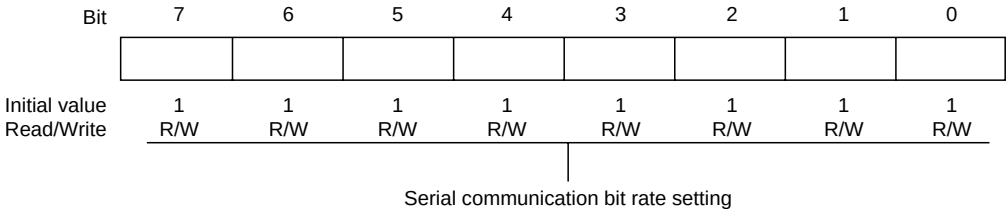
0	Asynchronous mode
1	Synchronous mode

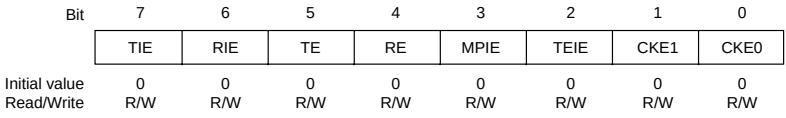
GSM mode (for smart card interface)

0	TEND flag is set 12.5 etu* after start bit
1	TEND flag is set 11.0 etu* after start bit

Note: * etu: Elementary time unit (time required to transmit one bit)

BRR—Bit Rate Register	H'FFFB1	SCI0





Bit	7	6	5	4	3	2	1	0
	TIE	RIE	TE	RE	MPIE	TEIE	CKE1	CKE0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Receive enable

0	Receiving is disabled
1	Receiving is enabled

Transmit enable

0	Transmitting is disabled
1	Transmitting is enabled

Clock enable 1 and 0
(for serial communication interface)

Bit 1	Bit 0	Description	
CKE1	CKE0		
0	0	Asynchronous mode	Internal clock, SCK pin available for generic I/O
		Synchronous mode	Internal clock, SCK pin used for serial clock output
	1	Asynchronous mode	Internal clock, SCK pin used for clock output
		Synchronous mode	Internal clock, SCK pin used for serial clock output
1	0	Asynchronous mode	External clock, SCK pin used for clock input
		Synchronous mode	External clock, SCK pin used for serial clock input
	1	Asynchronous mode	External clock, SCK pin used for clock input
		Synchronous mode	External clock, SCK pin used for serial clock input

Clock enable 1 and 0 (for smart card interface)

SMR	Bit 1	Bit 0	Description
GM	CKE1	CKE0	
0	0	0	SCK pin available for generic I/O
		1	SCK pin used for clock output
1	0	0	SCK pin output fixed low
		1	SCK pin used for clock output
	1	0	SCK pin output fixed high
		1	SCK pin used for clock output

Transmit-end interrupt enable

0	Transmit-end interrupt requests (TEI) are disabled
1	Transmit-end interrupt requests (TEI) are enabled

Multiprocessor interrupt enable

0	Multiprocessor interrupts are disabled (normal receive operation)
1	Multiprocessor interrupts are enabled

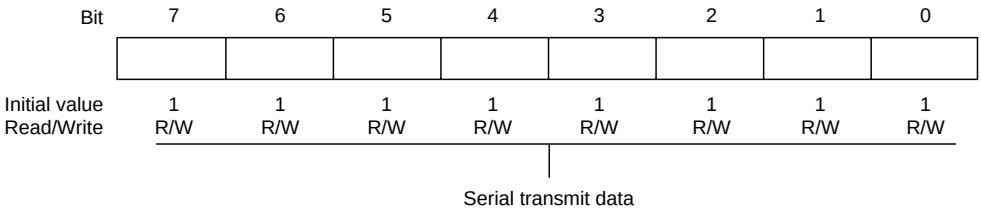
Receive interrupt enable

0	Receive-data-full (RXI) and receive-error (ERI) interrupt requests are disabled
1	Receive-data-full (RXI) and receive-error (ERI) interrupt requests are enabled

Transmit interrupt enable

0	Transmit-data-empty interrupt request (TXI) is disabled
1	Transmit-data-empty interrupt request (TXI) is enabled

TDR—Transmit Data Register	H'FFFB3	SCI0



Bit	7	6	5	4	3	2	1	0
	TDRE	RDRF	ORER	FER/ERS	PER	TEND	MPB	MPBT
Initial value	1	0	0	0	0	1	0	0
Read/Write	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R	R	R/W

Multiprocessor bit transfer

0	Multiprocessor bit value in transmit data is 0
1	Multiprocessor bit value in transmit data is 1

Multiprocessor bit

0	Multiprocessor bit value in receive data is 0
1	Multiprocessor bit value in receive data is 1

Transmit end (for serial communication interface)

0	[Clearing conditions] Read TDRE when TDRE = 1, then write 0 in TDRE. The DMAC writes data in TDR.
1	[Setting conditions] Reset or transition to standby mode TE is cleared to 0 in SCR. TDRE is 1 when last bit of 1-byte serial character is transmitted.

Transmit end (for smart card interface)

0	[Clearing conditions] Read TDRE when TDRE = 1, then write 0 in TDRE. The DMAC writes data in TDR.
1	[Setting conditions] Reset or transition to standby mode TE is cleared to 0 in SCR and FER/ERS is cleared to 0. TDRE is 1 and FER/ERS is 0 (normal transmission) 2.5 etu*1 (when GM = 0) or 1.0 etu (when GM = 1) after 1-byte serial character is transmitted.

Note: *1 etu: Elementary time unit (time required to transmit one bit)

Parity error

0	[Clearing conditions]	Reset or transition to standby mode. Read PER when PER = 1, then write 0 in PER
1	[Setting condition]	Parity error (parity of receive data does not match parity setting of O/E bit in SMR)

Framing error (for serial communication interface)

0	[Clearing conditions]	Reset or transition to standby mode. Read FER when FER = 1, then write 0 in FER
1	[Setting condition]	Framing error (stop bit is 0)

Error signal status (for smart card interface)

0	[Clearing conditions]	Reset or transition to standby mode. Read ERS when ERS = 1, then write 0 in ERS
1	[Setting condition]	A low error signal is received

Overrun error

0	[Clearing conditions]	Reset or transition to standby mode. Read ORER when ORER = 1, then write 0 in ORER
1	[Setting condition]	Overrun error (reception of the next serial data ends when RDRF = 1)

Receive data register full

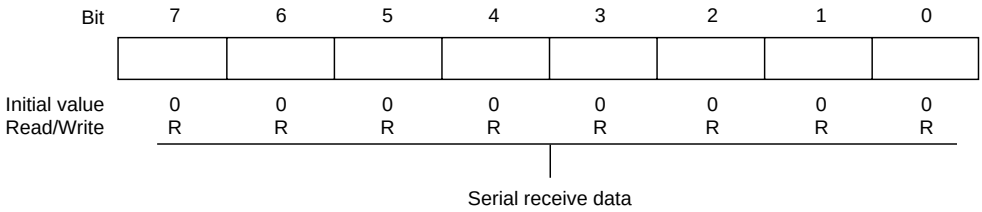
0	[Clearing conditions]	Reset or transition to standby mode. Read RDRF when RDRF = 1, then write 0 in RDRF The DMAC reads data from RDR
1	[Setting condition]	Serial data is received normally and transferred from RSR to RDR

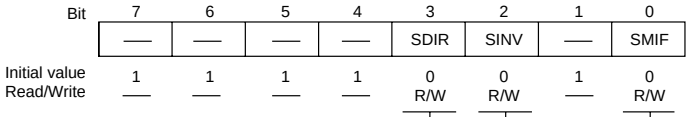
Transmit data register empty

0	[Clearing conditions]	Read TDRE when TDRE = 1, then write 0 in TDRE The DMAC writes data in TDR
1	[Setting conditions]	Reset or transition to standby mode. TE is 0 in SCR Data is transferred from TDR to TSR, enabling new data to be written in TDR.

Note: * Only 0 can be written, to clear the flag.

RDR—Receive Data Register	H'FFFB5	SCI0





Smart card interface mode select

0	Smart card interface function is disabled	(Initial value)
1	Smart card interface function is enabled	

Smart card data invert

0	Unmodified TDR contents are transmitted Receive data is stored unmodified in RDR	(Initial value)
1	Inverted 1/0 logic levels of TDR contents are transmitted 1/0 logic levels of received data are inverted before storage in RDR	

Smart card data transfer direction

0	TDR contents are transmitted LSB-first Receive data is stored LSB-first in RDR	(Initial value)
1	TDR contents are transmitted MSB-first Receive data is stored MSB-first in RDR	

SMR—Serial Mode Register	H'FFFB8	SCI1

Bit	7	6	5	4	3	2	1	0
	C/$\overline{A}$	CHR	PE	O/$\overline{E}$	STOP	MP	CKS1	CKS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Note: Bit functions are the same as for SCI0.

BRR—Bit Rate Register	H'FFFB9	SCI1

Bit	7	6	5	4	3	2	1	0
Initial value	1	1	1	1	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Note: Bit functions are the same as for SCI0.

SCR—Serial Control Register	H'FFFBA	SCI1

Bit	7	6	5	4	3	2	1	0
	TIE	RIE	TE	RE	MPIE	TEIE	CKE1	CKE0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Note: Bit functions are the same as for SCI0.

TDR—Transmit Data Register	H'FFFBB	SCI1

Bit	7	6	5	4	3	2	1	0
Initial value	1	1	1	1	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Note: Bit functions are the same as for SCI0.

SSR—Serial Status Register	H'FFFBC	SCI1

Bit	7	6	5	4	3	2	1	0
	TDRE	RDRF	ORER	FER/ERS	PER	TEND	MPB	MPBT
Initial value	0	0	0	0	0	1	0	0
Read/Write	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R	R	R/W

Notes: Bit functions are the same as for SCI0.

* Only 0 can be written, to clear the flag.

RDR—Receive Data Register	H'FFFBD	SCI1

Bit	7	6	5	4	3	2	1	0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R	R	R	R	R	R	R	R

Note: Bit functions are the same as for SCI0.

SCMR—Smart Card Mode Register	H'FFFBE	SCI1

Bit	7	6	5	4	3	2	1	0
	—	—	—	—	SDIR	SINV	—	SMIF
Initial value	1	1	1	1	0	0	1	0
Read/Write	—	—	—	—	R/W	R/W	—	R/W

Note: Bit functions are the same as for SCI0.

SMR—Serial Mode Register	H'FFFC0	SCI2

Bit	7	6	5	4	3	2	1	0
	C/$\overline{A}$	CHR	PE	O/$\overline{E}$	STOP	MP	CKS1	CKS0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Note: Bit functions are the same as for SCI0.

BRR—Bit Rate Register	H'FFFC1	SCI2

Bit	7	6	5	4	3	2	1	0
Initial value	1	1	1	1	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Note: Bit functions are the same as for SCI0.

SCR—Serial Control Register	H'FFFC2	SCI2

Bit	7	6	5	4	3	2	1	0
	TIE	RIE	TE	RE	MPIE	TEIE	CKE1	CKE0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Note: Bit functions are the same as for SCI0.

TDR—Transmit Data Register	H'FFFC3	SCI2

Bit	7	6	5	4	3	2	1	0
Initial value	1	1	1	1	1	1	1	1
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Note: Bit functions are the same as for SCI0.

SSR—Serial Status Register	H'FFFC4	SCI2

Bit	7	6	5	4	3	2	1	0
	TDRE	RDRF	ORER	FER/ERS	PER	TEND	MPB	MPBT
Initial value	1	0	0	0	0	1	0	0
Read/Write	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R/(W)*	R	R	R/W

Notes: Bit functions are the same as for SCI0.
* Only 0 can be written, to clear the flag.

RDR—Receive Data Register	H'FFFC5	SCI2

Bit	7	6	5	4	3	2	1	0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R	R	R	R	R	R	R	R

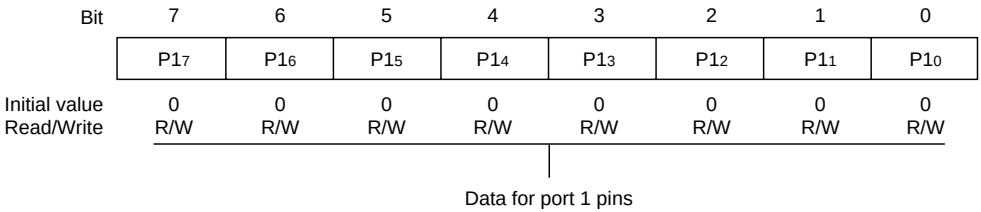
Note: Bit functions are the same as for SCI0.

SCMR—Smart Card Mode Register	H'FFFC6	SCI2

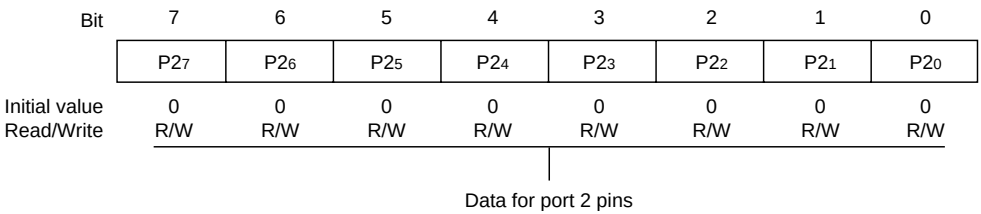
Bit	7	6	5	4	3	2	1	0
	—	—	—	—	SDIR	SINV	—	SMIF
Initial value	1	1	1	1	0	0	1	0
Read/Write	—	—	—	—	R/W	R/W	—	R/W

Note: Bit functions are the same as for SCI0.

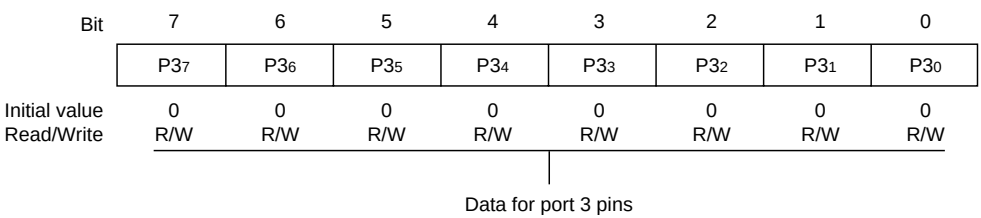
P1DR—Port 1 Data Register	H'FFFD0	Port 1



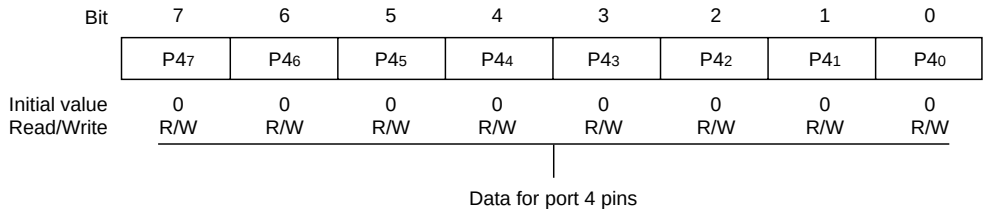
P2DR—Port 2 Data Register	H'FFFD1	Port 2



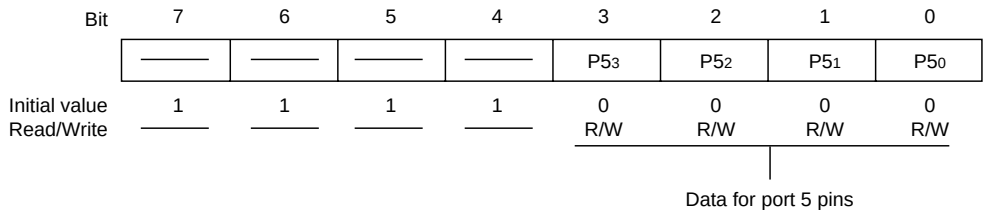
P3DR—Port 3 Data Register	H'FFFD2	Port 3



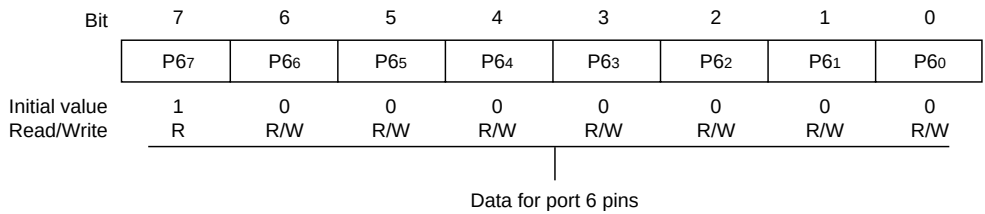
P4DR—Port 4 Data Register	H'FFFD3	Port 4



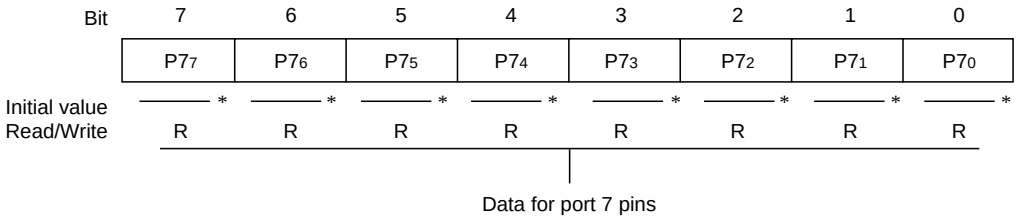
P5DR—Port 5 Data Register	H'FFFD4	Port 5



P6DR—Port 6 Data Register	H'FFFD5	Port 6

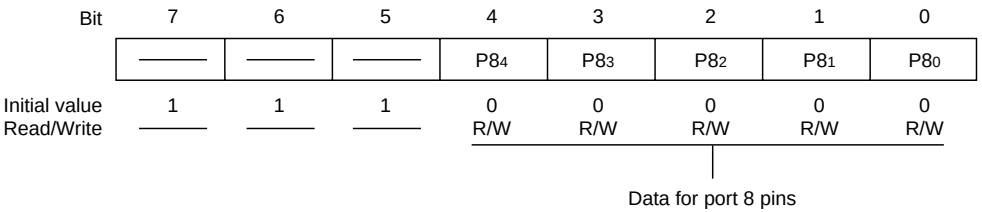


P7DR—Port 7 Data Register	H'FFFD6	Port 7



Note: * Determined by pins $P7_7$ to $P7_0$.

P8DR—Port 8 Data Register	H'FFFD7	Port 8



P9DR—Port 9 Data Register	H'FFFD8	Port 9

Bit	7	6	5	4	3	2	1	0
	—	—	$P9_5$	$P9_4$	$P9_3$	$P9_2$	$P9_1$	$P9_0$
Initial value	1	1	0	0	0	0	0	0
Read/Write	—	—	R/W	R/W	R/W	R/W	R/W	R/W

Data for port 9 pins

PADR—Port A Data Register	H'FFFD9	Port A

Bit	7	6	5	4	3	2	1	0
	PA_7	PA_6	PA_5	PA_4	PA_3	PA_2	PA_1	PA_0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

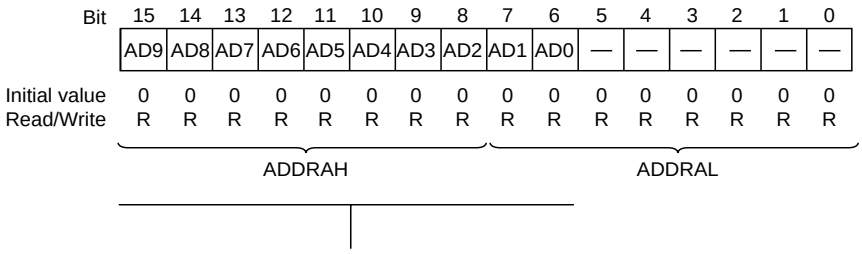
Data for port A pins

PBDR—Port B Data Register	H'FFFDA	Port B

Bit	7	6	5	4	3	2	1	0
	PB_7	PB_6	PB_5	PB_4	PB_3	PB_2	PB_1	PB_0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W

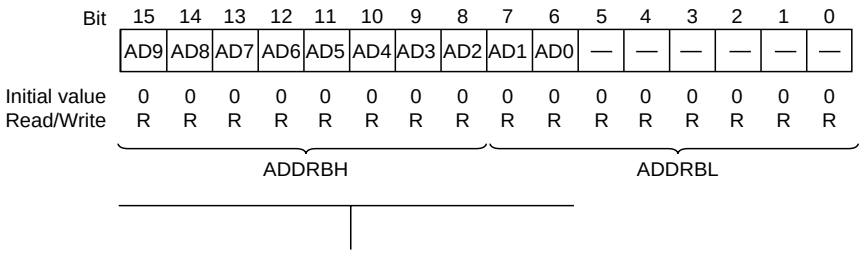
Data for port B pins

ADDRA H/L—A/D Data Register A H/L	H'FFFE0, H'FFFE1	A/D



A/D conversion data
10-bit data giving an A/D conversion result

ADDRB H/L—A/D Data Register B H/L	H'FFFE2, H'FFFE3	A/D



A/D conversion data
10-bit data giving an A/D conversion result

ADDRC H/L—A/D Data Register C H/L

H'FFFE4, H'FFFE5 | A/D

Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	AD9	AD8	AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0	—	—	—	—	—	—
Initial value	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Read/Write	R	R	R	R	R	R	R	R	R	R	R	R	R	R	R	R
	ADDRCH								ADDRCL							

A/D conversion data
10-bit data giving an A/D conversion result

ADDRD H/L—A/D Data Register D H/L

H'FFFE6, H'FFFE7 | A/D

Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	AD9	AD8	AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0	—	—	—	—	—	—
Initial value	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Read/Write	R	R	R	R	R	R	R	R	R	R	R	R	R	R	R	R
	ADDRDH								ADDRDL							

A/D conversion data
10-bit data giving an A/D conversion result

ADCR—A/D Control Register

H'FFFE9 | A/D

Bit	7	6	5	4	3	2	1	0
	TRGE	—	—	—	—	—	—	—
Initial value	0	1	1	1	1	1	1	0
Read/Write	R/W	—	—	—	—	—	—	R/W

Trigger Enable

0	A/D conversion start by external trigger or 8-bit timer compare match is disabled
1	A/D conversion is started by falling edge of external trigger signal ($\overline{\text{ADTRG}}$) or 8-bit timer compare match

Bit	7	6	5	4	3	2	1	0
	ADF	ADIE	ADST	SCAN	CKS	CH2	CH1	CH0
Initial value	0	0	0	0	0	0	0	0
Read/Write	R/(W)*	R/W	R/W	R/W	R/W	R/W	R/W	R/W

Clock select

0	Conversion time = 134 states (maximum)
1	Conversion time = 70 states (maximum)

Channel select 2 to 0

Group Selection	Channel Selection		Description	
CH2	CH1	CH0	Single Mode	Scan Mode
0	0	0	AN_0	AN_0
		1	AN_1	AN_0, AN_1
	1	0	AN_2	AN_0 to AN_2
		1	AN_3	AN_0 to AN_3
1	0	0	AN_4	AN_4
		1	AN_5	AN_4, AN_5
	1	0	AN_6	AN_4 to AN_6
		1	AN_7	AN_4 to AN_7

Scan mode

0	Single mode
1	Scan mode

A/D start

0	A/D conversion is stopped
1	Single mode: A/D conversion starts; ADST is automatically cleared to 0 when conversion ends Scan mode: A/D conversion starts and continues, cycling among the selected channels ADST is cleared to 0 by software, by a reset, or by a transition to standby mode

A/D interrupt enable

0	A/D end interrupt request is disabled
1	A/D end interrupt request is enabled

A/D end flag

0	[Clearing conditions] Read ADF when ADF = 1, then write 0 in ADF The DMAC is activated by an ADI interrupt
1	[Setting conditions] Single mode: A/D conversion ends Scan mode: A/D conversion ends in all selected channels

Note: * Only 0 can be written, to clear the flag.

Appendix C I/O Port Block Diagrams

C.1 Port 1 Block Diagram

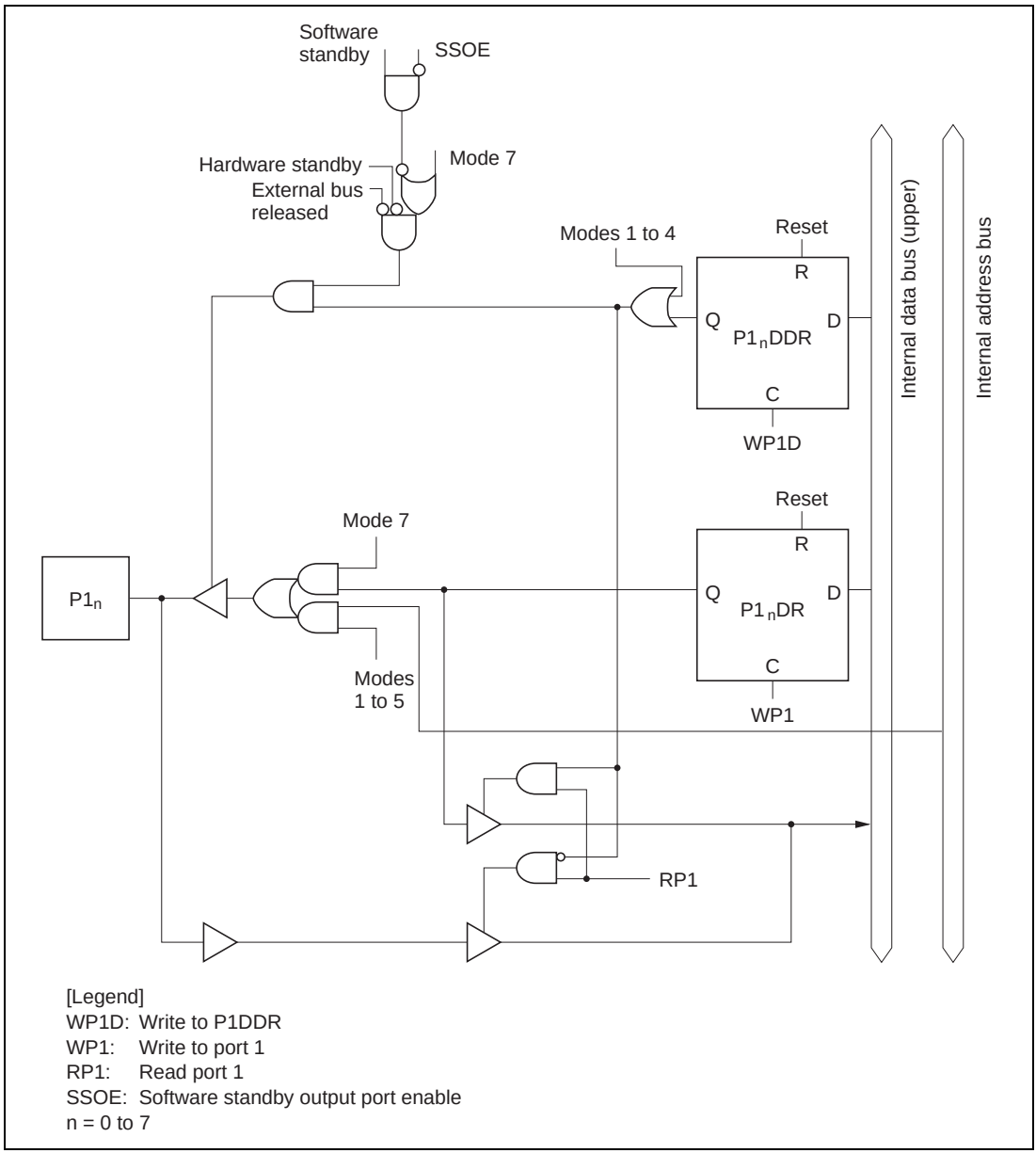


Figure C.1 Port 1 Block Diagram

C.2 Port 2 Block Diagram

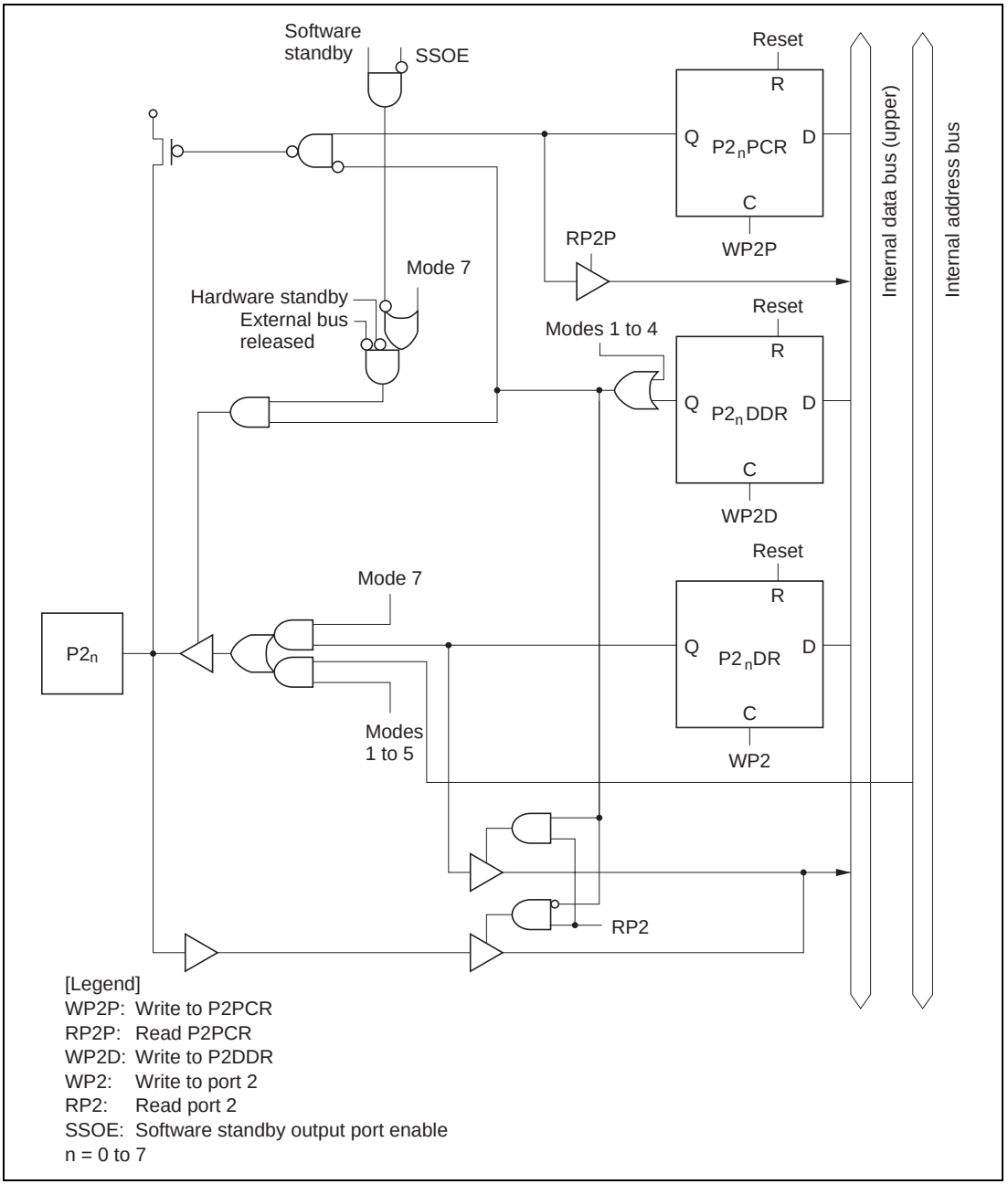


Figure C.2 Port 2 Block Diagram

C.3 Port 3 Block Diagram

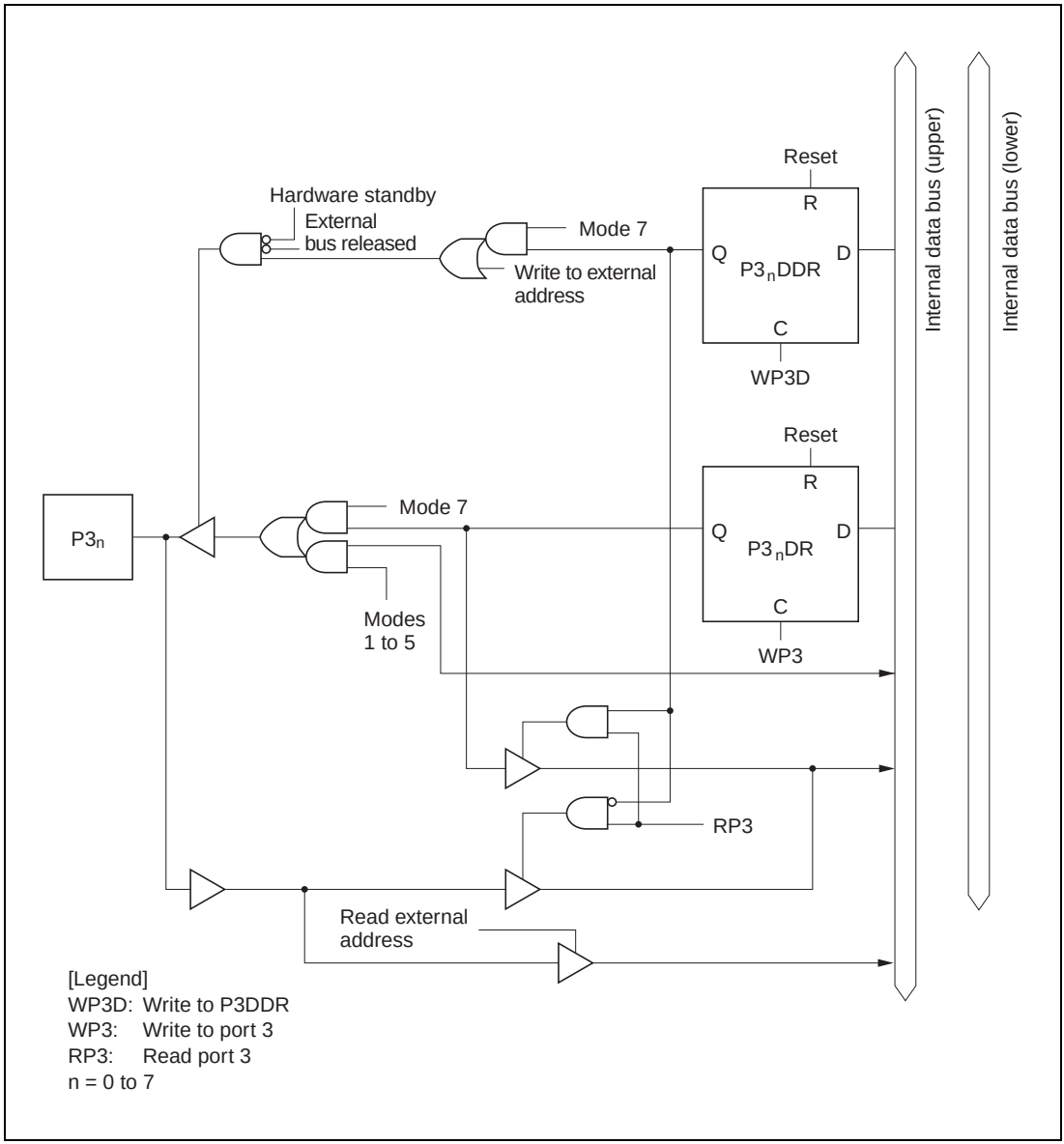


Figure C.3 Port 3 Block Diagram

C.4 Port 4 Block Diagram

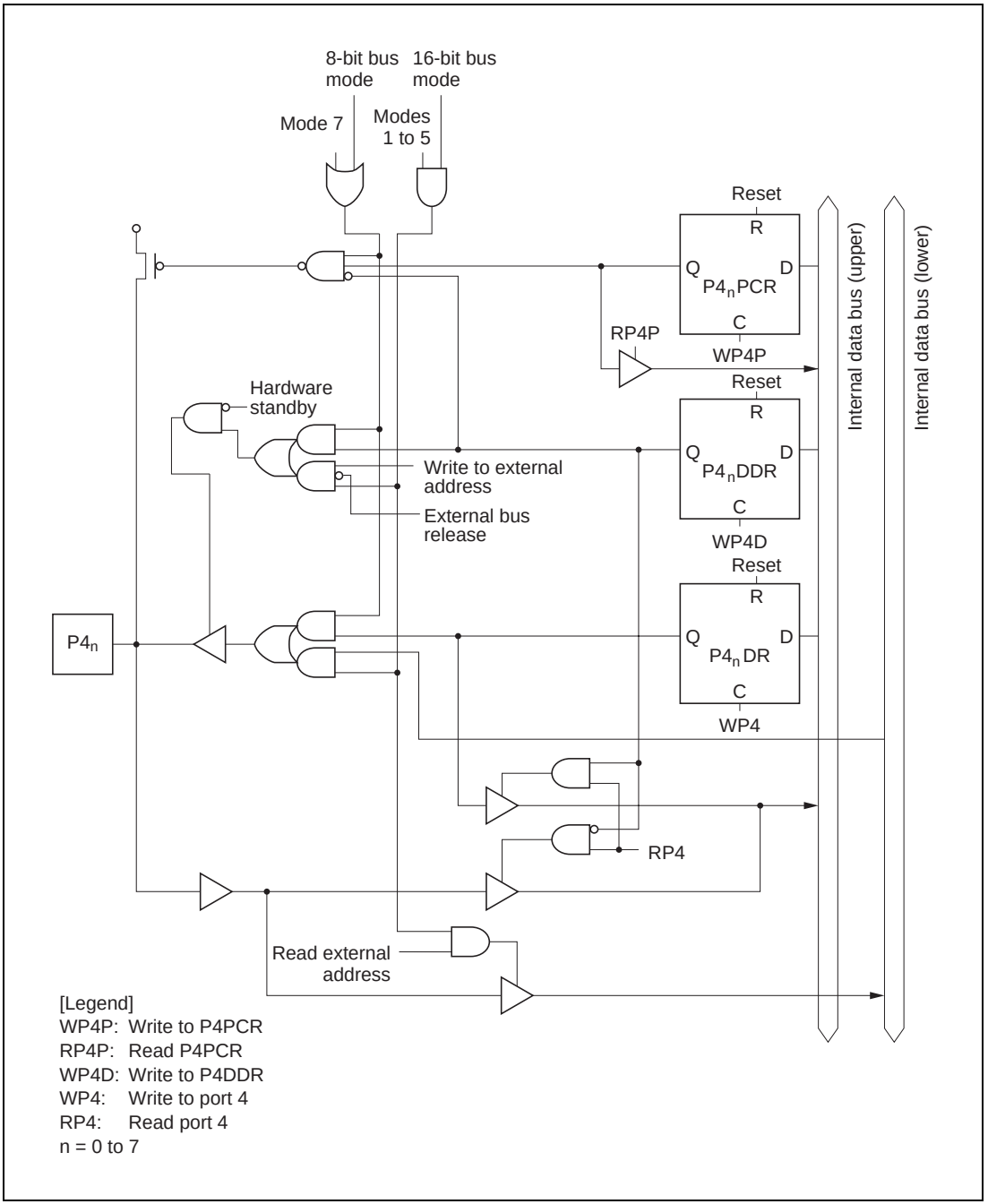


Figure C.4 Port 4 Block Diagram

C.5 Port 5 Block Diagram

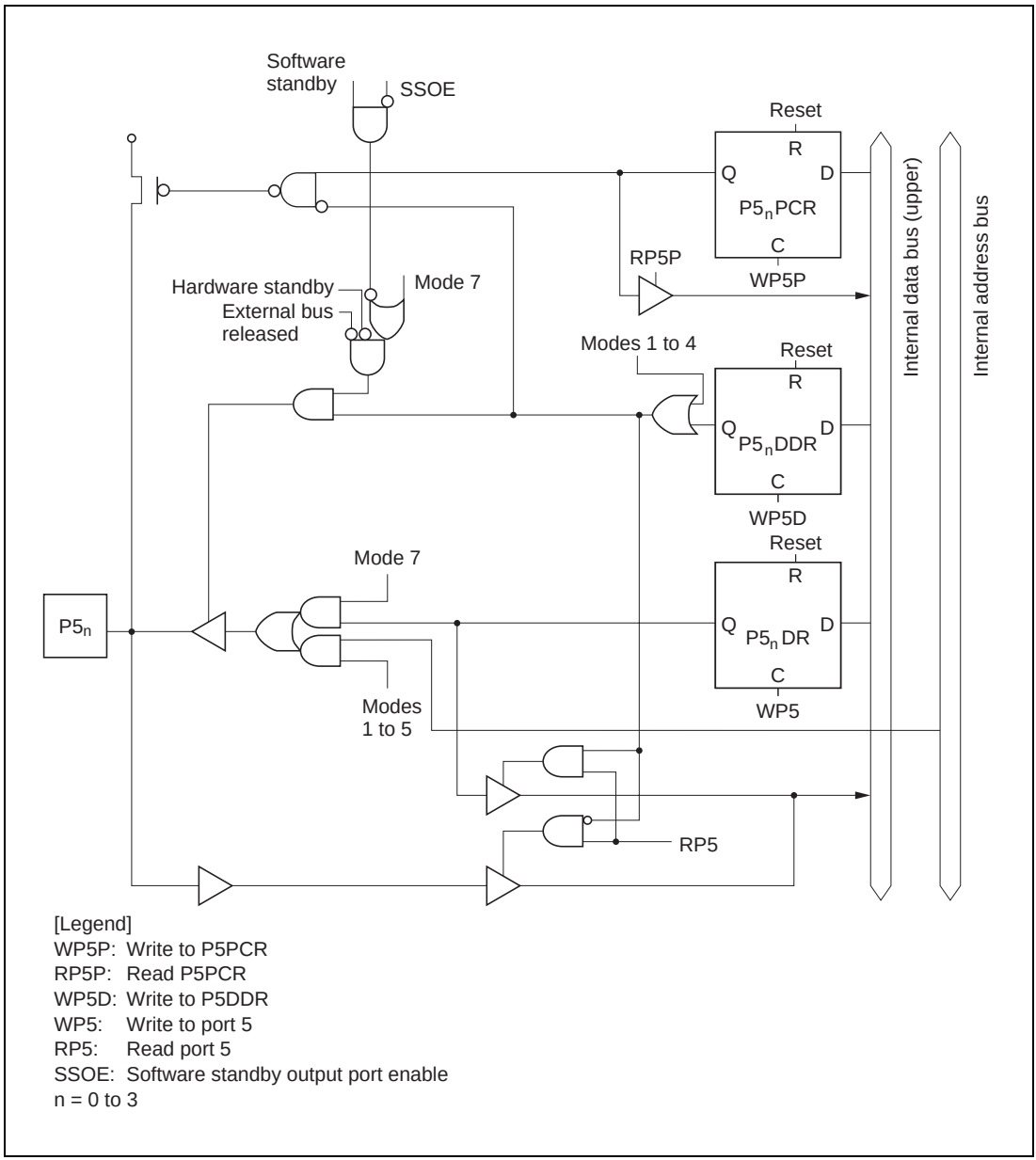


Figure C.5 Port 5 Block Diagram

C.6 Port 6 Block Diagrams

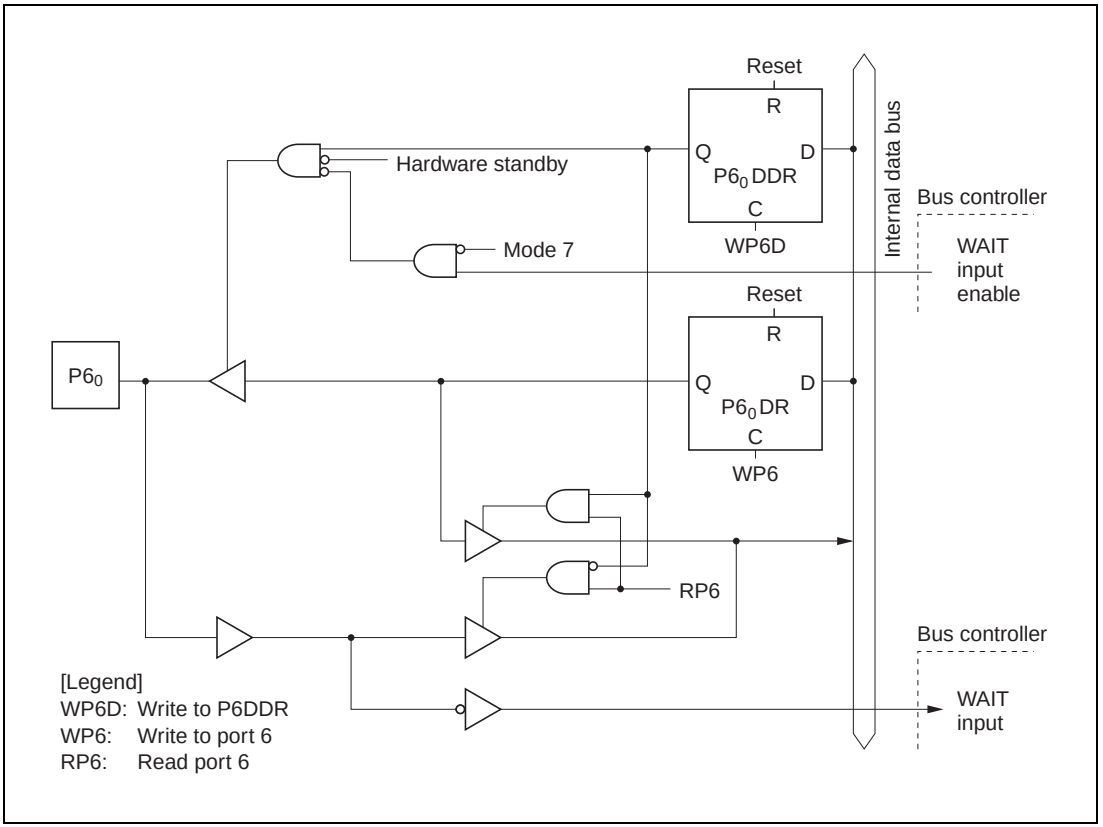


Figure C.6 (a) Port 6 Block Diagram (Pin $P6_0$)

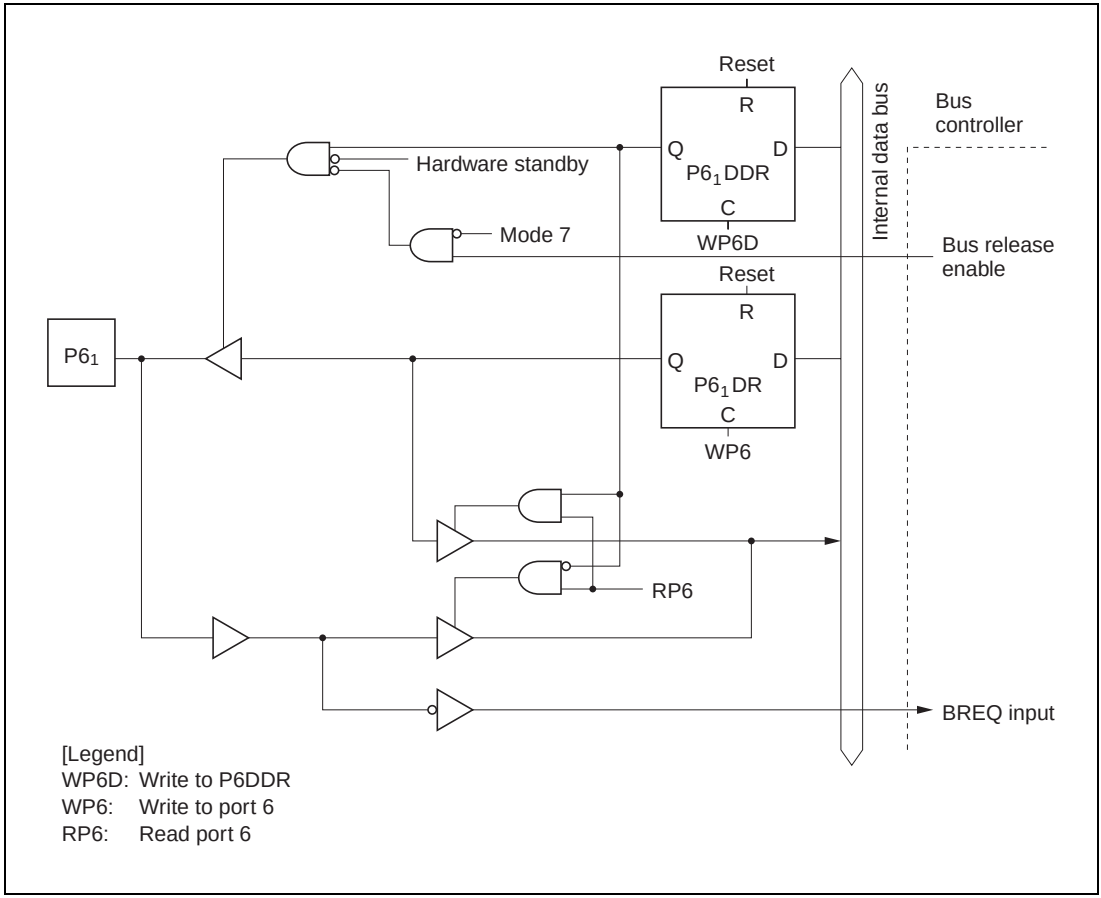


Figure C.6 (b) Port 6 Block Diagram (Pin P6$_1$)

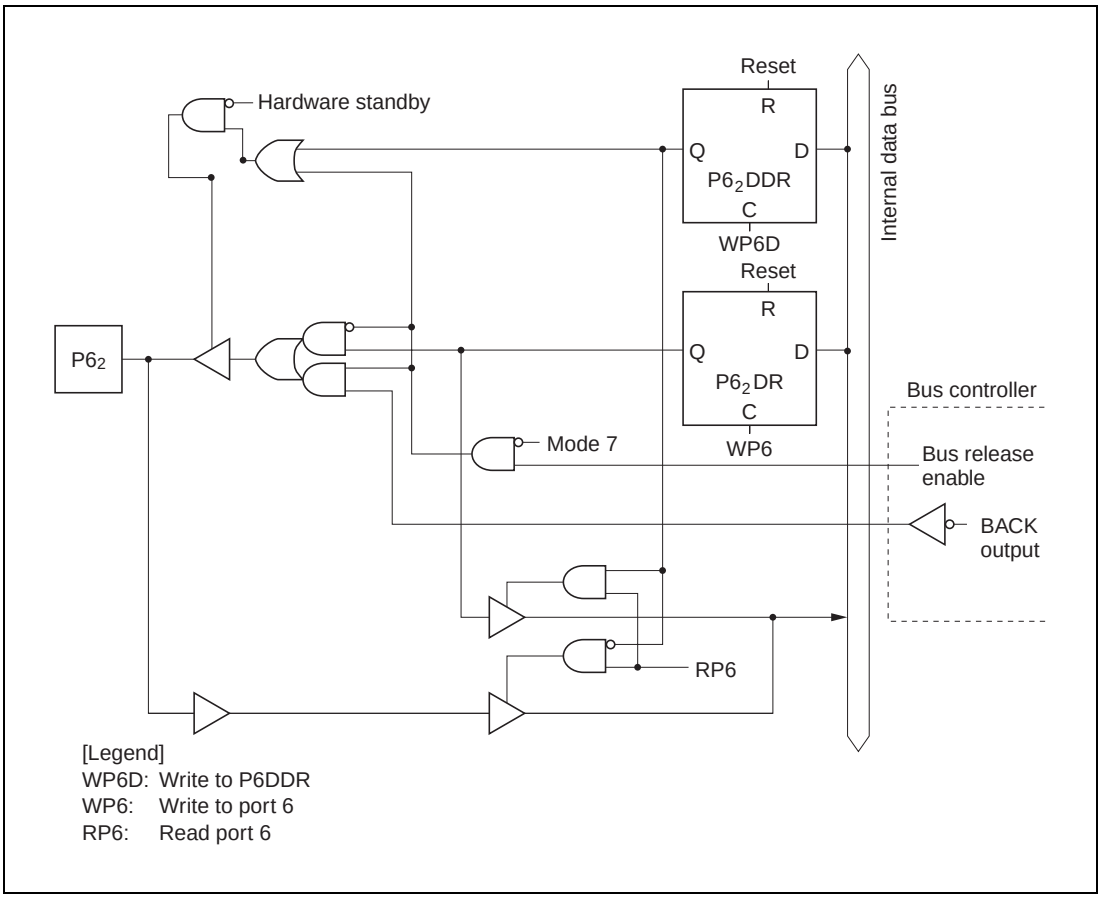


Figure C.6 (c) Port 6 Block Diagram (Pin P6$_2$)

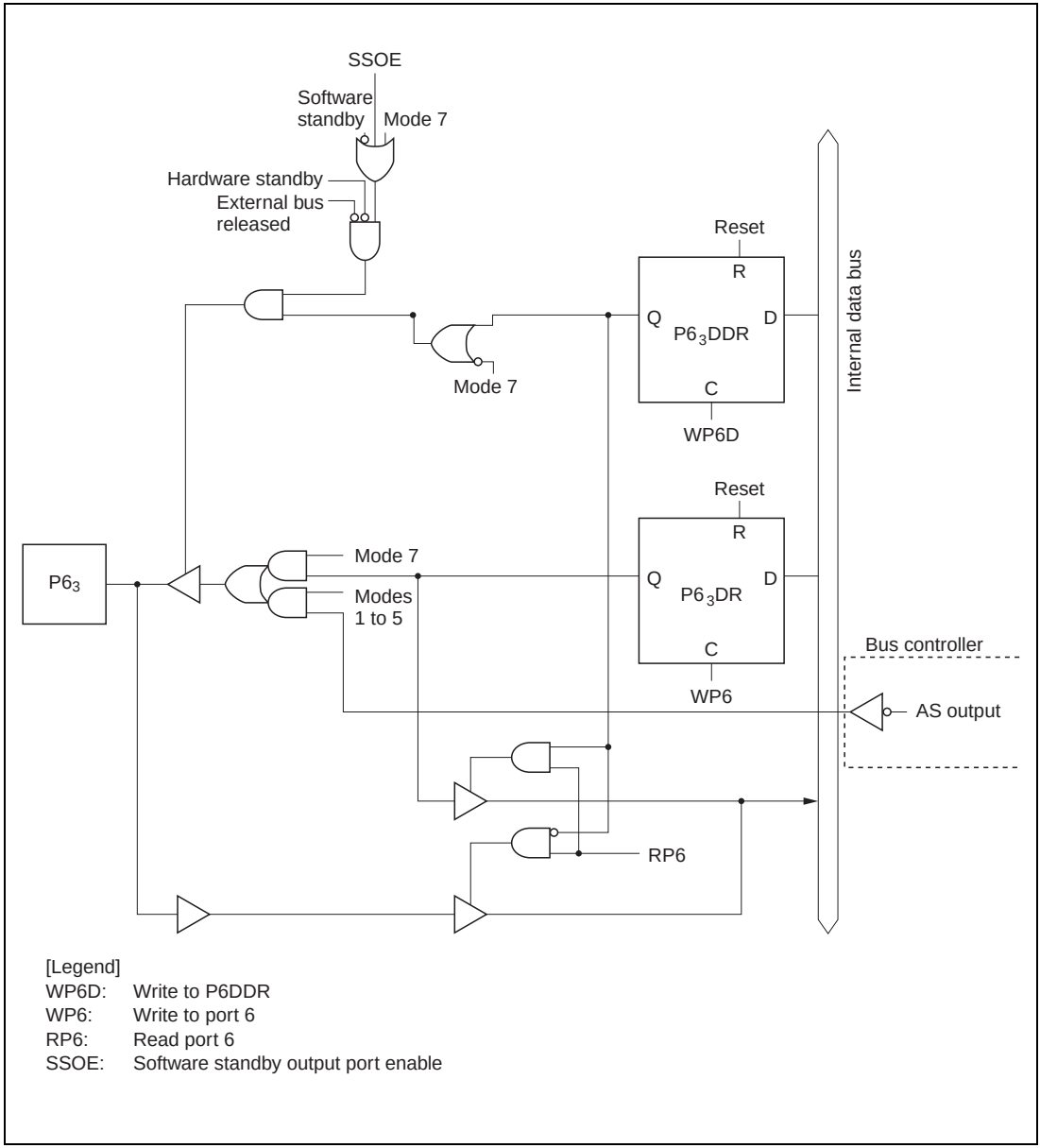


Figure C.6 (d) Port 6 Block Diagram (Pin P6$_3$)

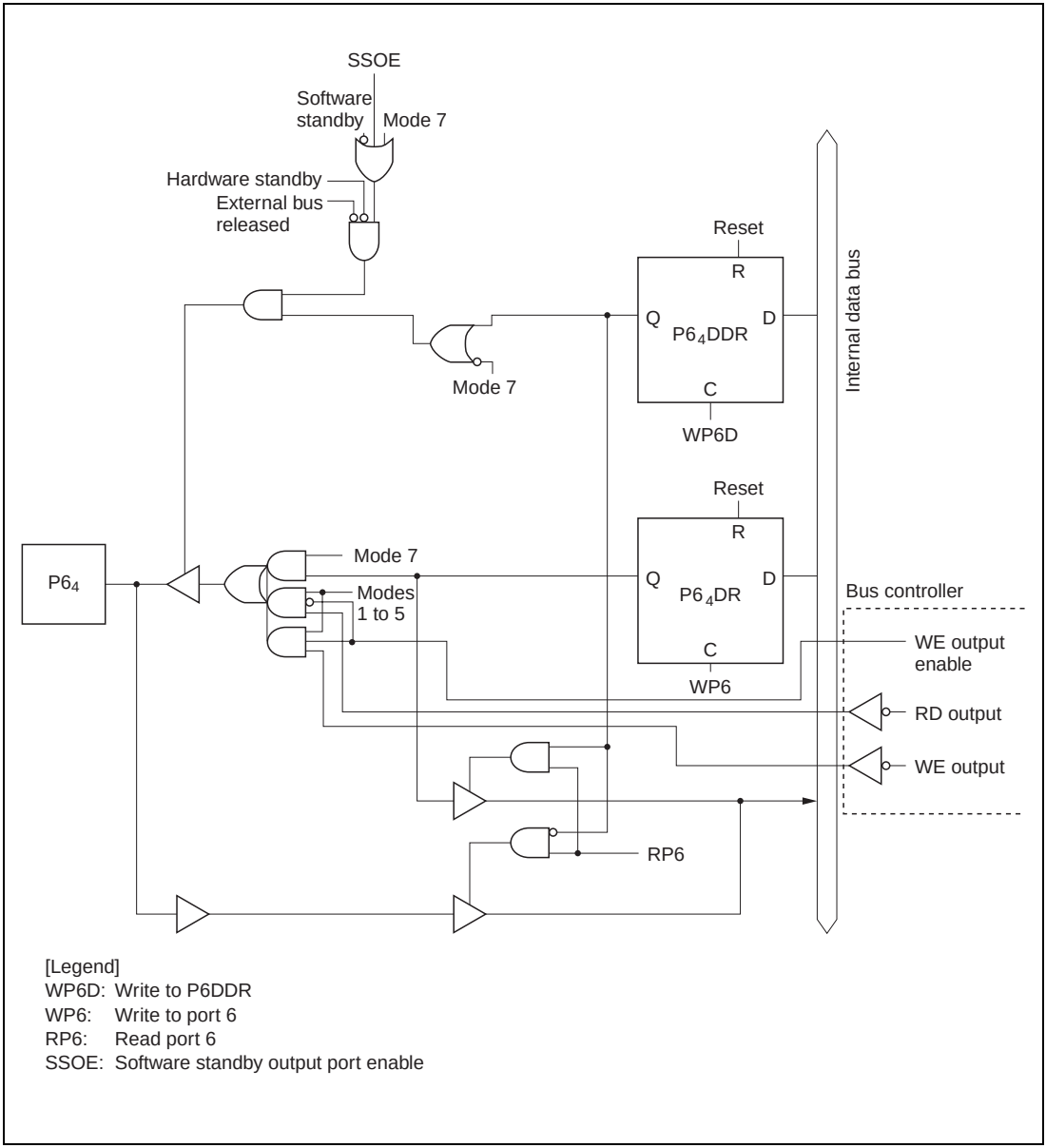
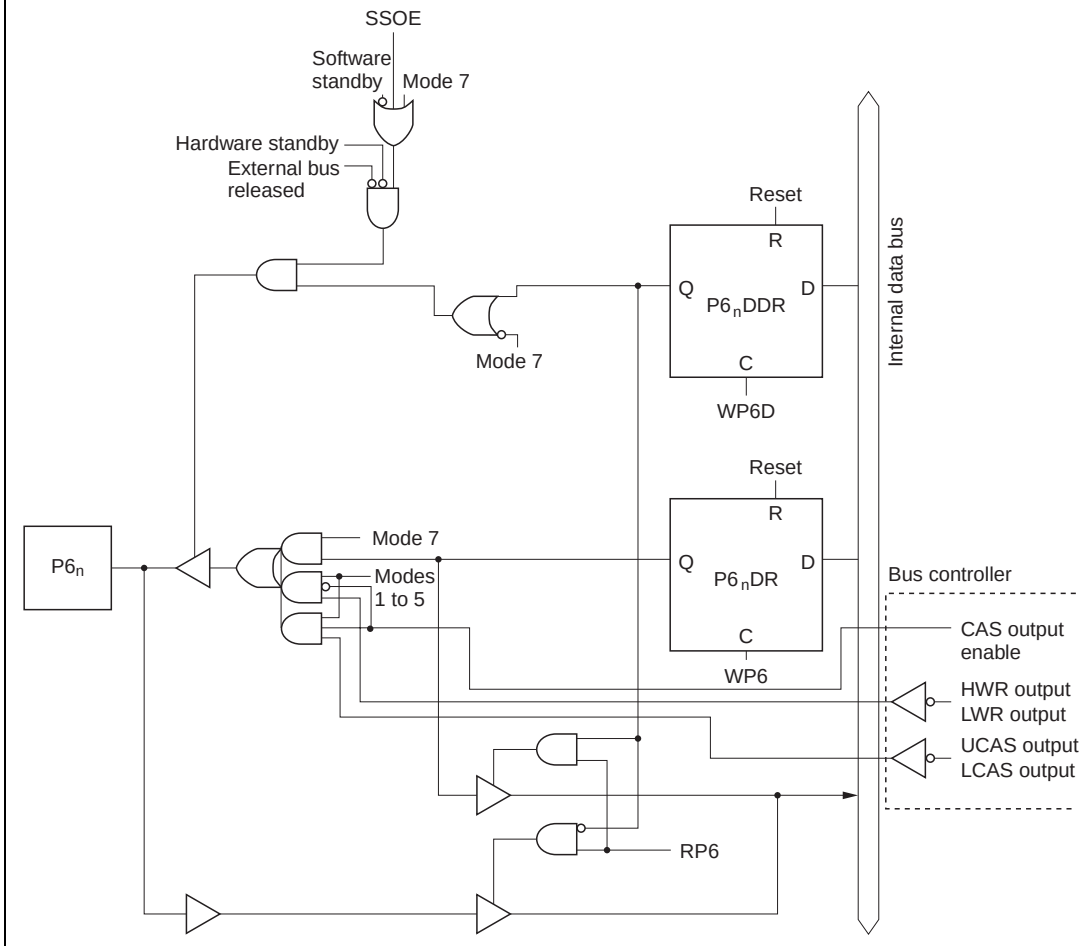


Figure C.6 (e) Port 6 Block Diagram (Pin P6$_4$)



[Legend]
WP6D: Write to P6DDR
WP6: Write to port 6
RP6: Read port 6
SSOE: Software standby output port enable
n = 5 and 6

Figure C.6 (f) Port 6 Block Diagram (Pins $P6_5$ and $P6_6$)

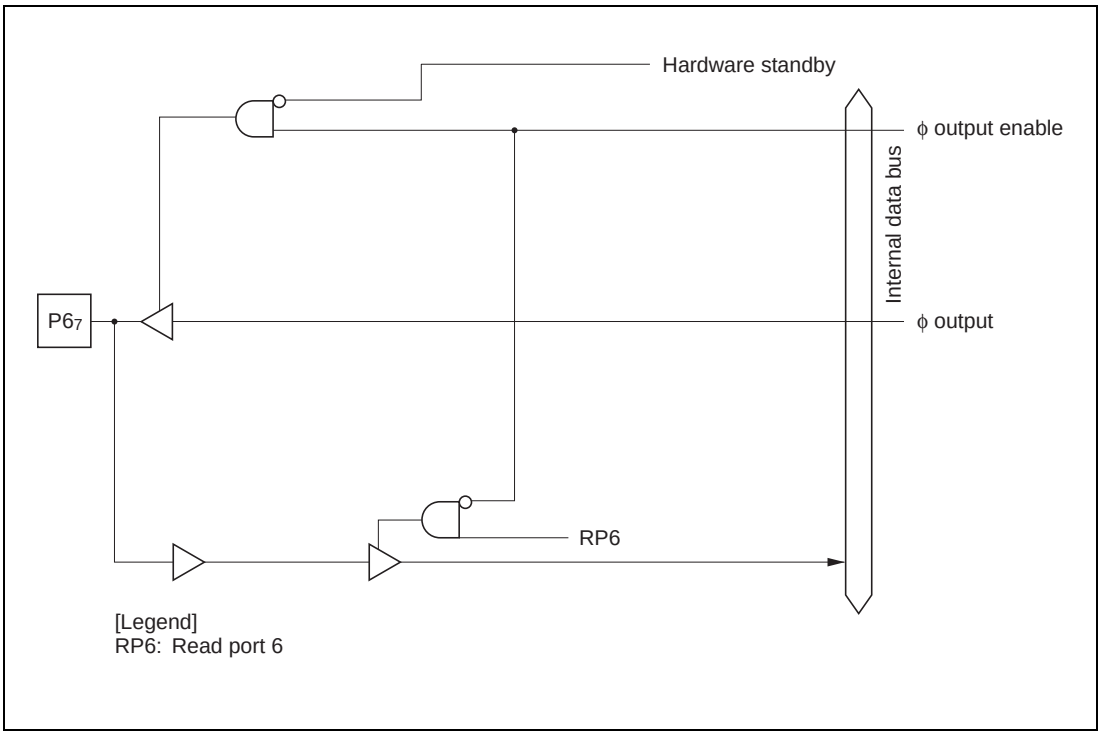


Figure C.6 (g) Port 6 Block Diagram (Pin $P6_7$)

C.7 Port 7 Block Diagrams

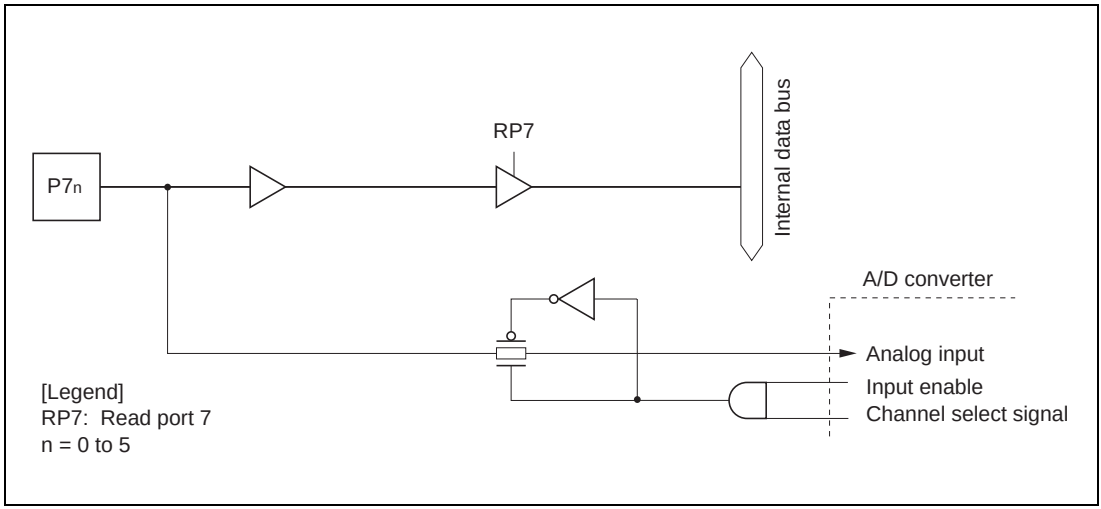


Figure C.7 (a) Port 7 Block Diagram (Pins $P7_0$ to $P7_5$)

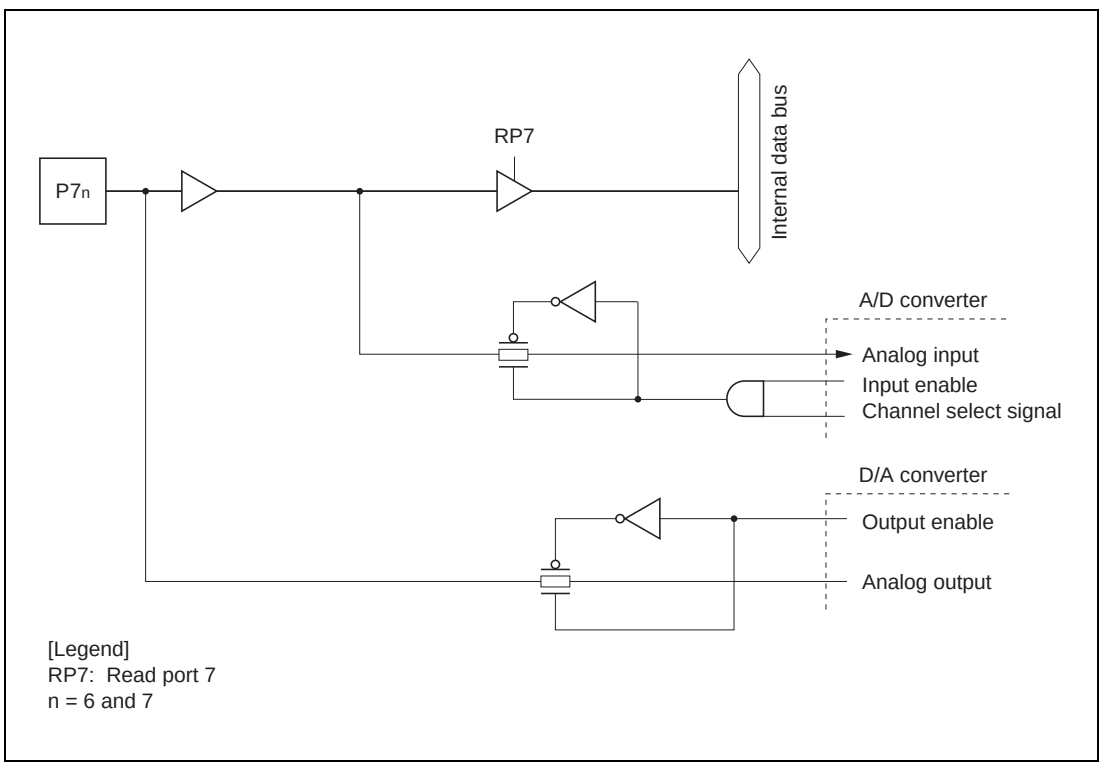


Figure C.7 (b) Port 7 Block Diagram (Pins $P7_6$ and $P7_7$)

C.8 Port 8 Block Diagrams

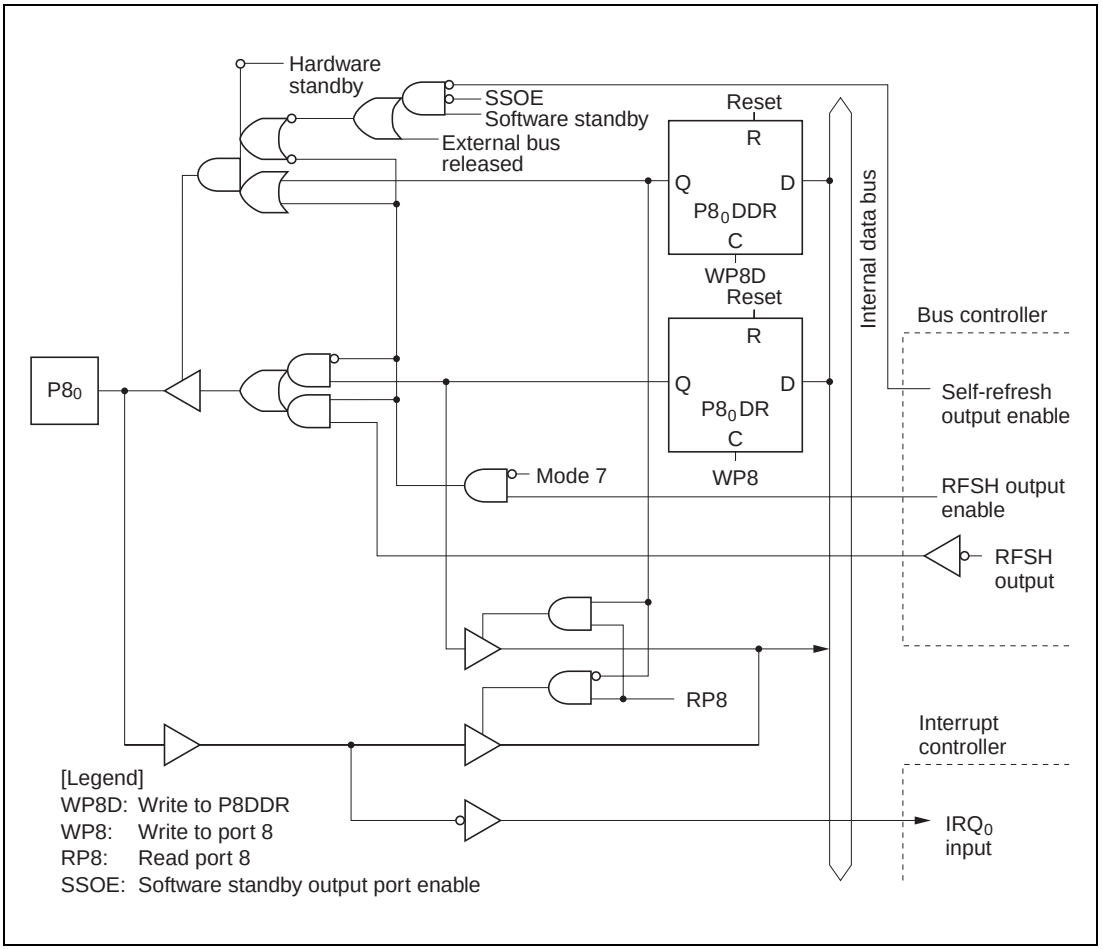


Figure C.8 (a) Port 8 Block Diagram (Pin P8$_0$)

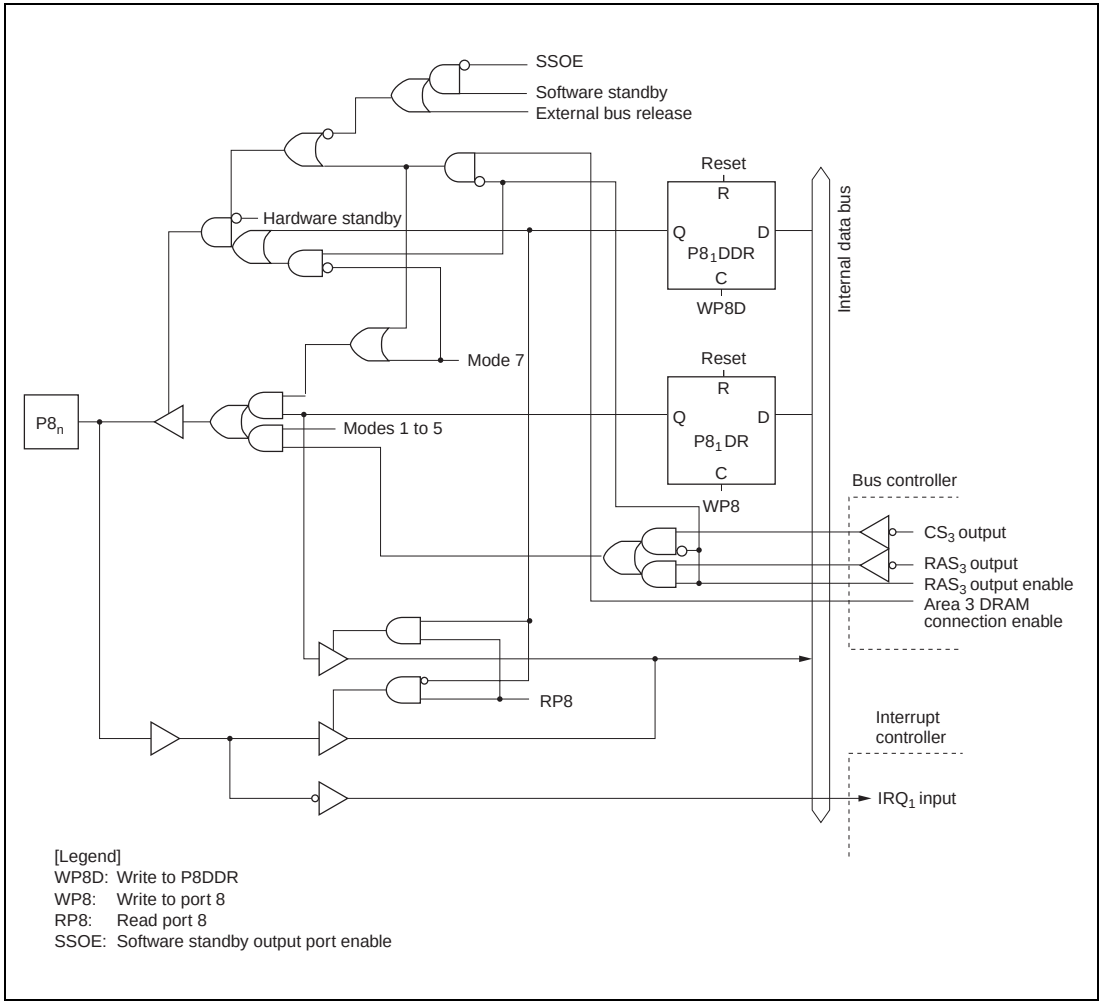


Figure C.8 (b) Port 8 Block Diagram (Pin P8$_1$)

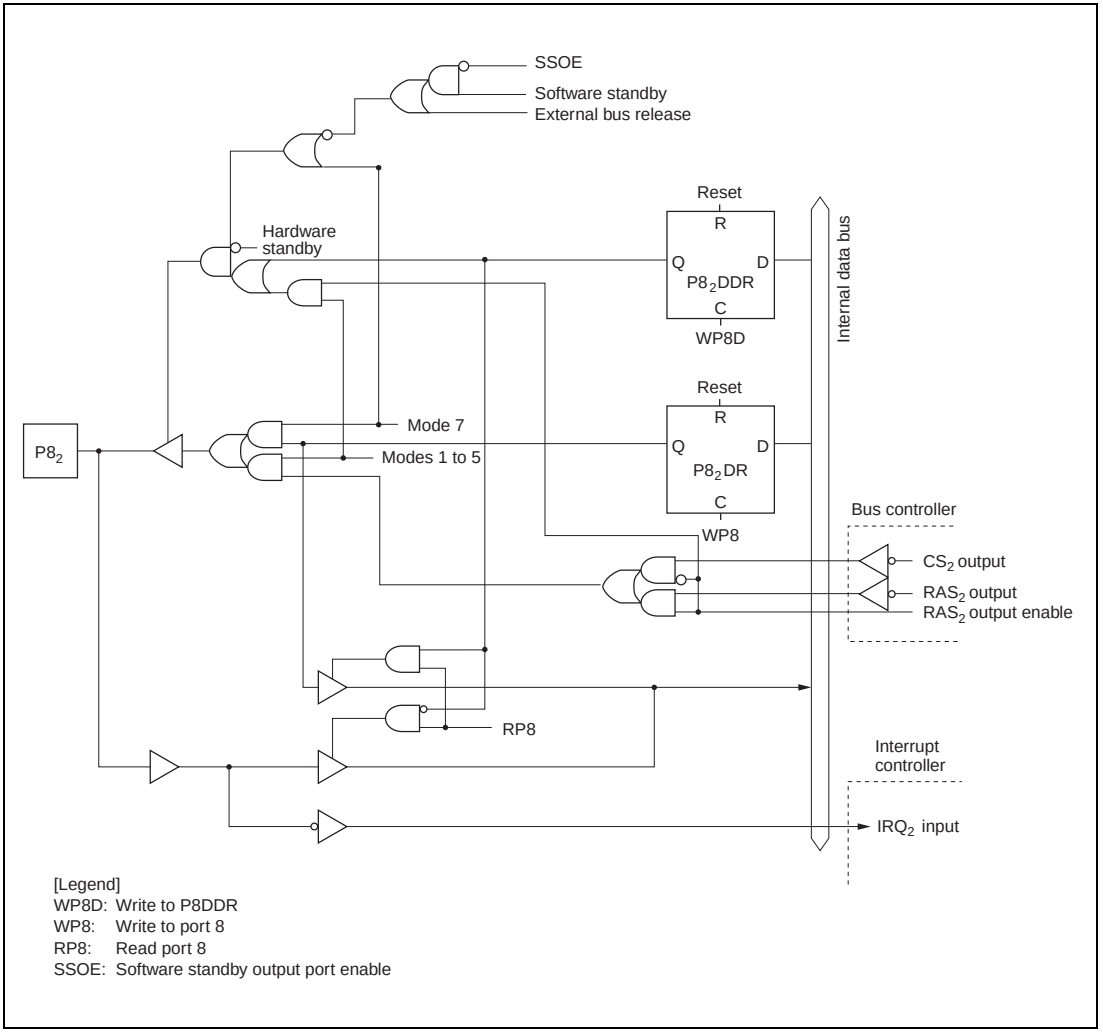


Figure C.8 (c) Port 8 Block Diagram (Pin P8$_2$)

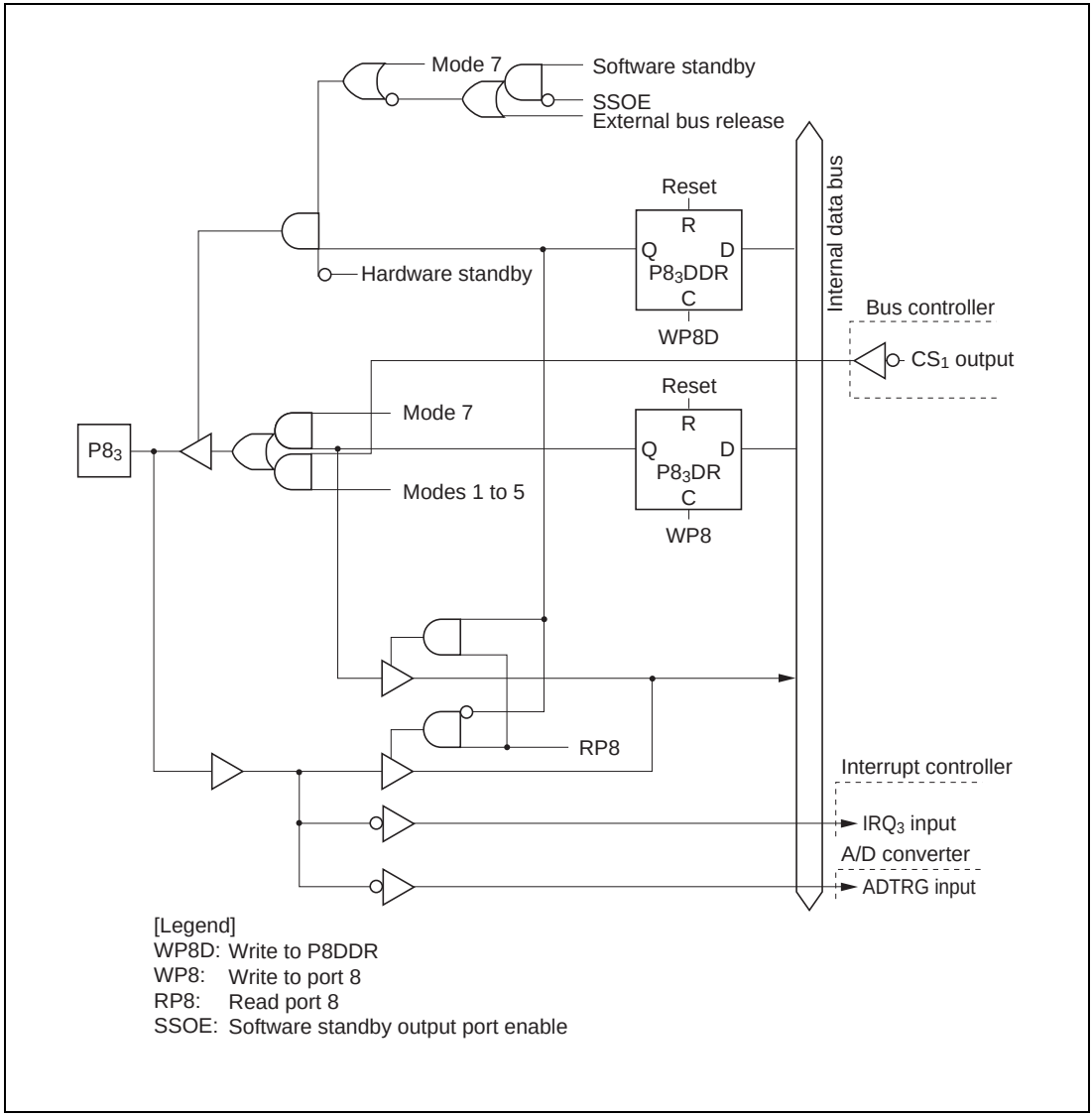


Figure C.8 (d) Port 8 Block Diagram (Pin $P8_3$)

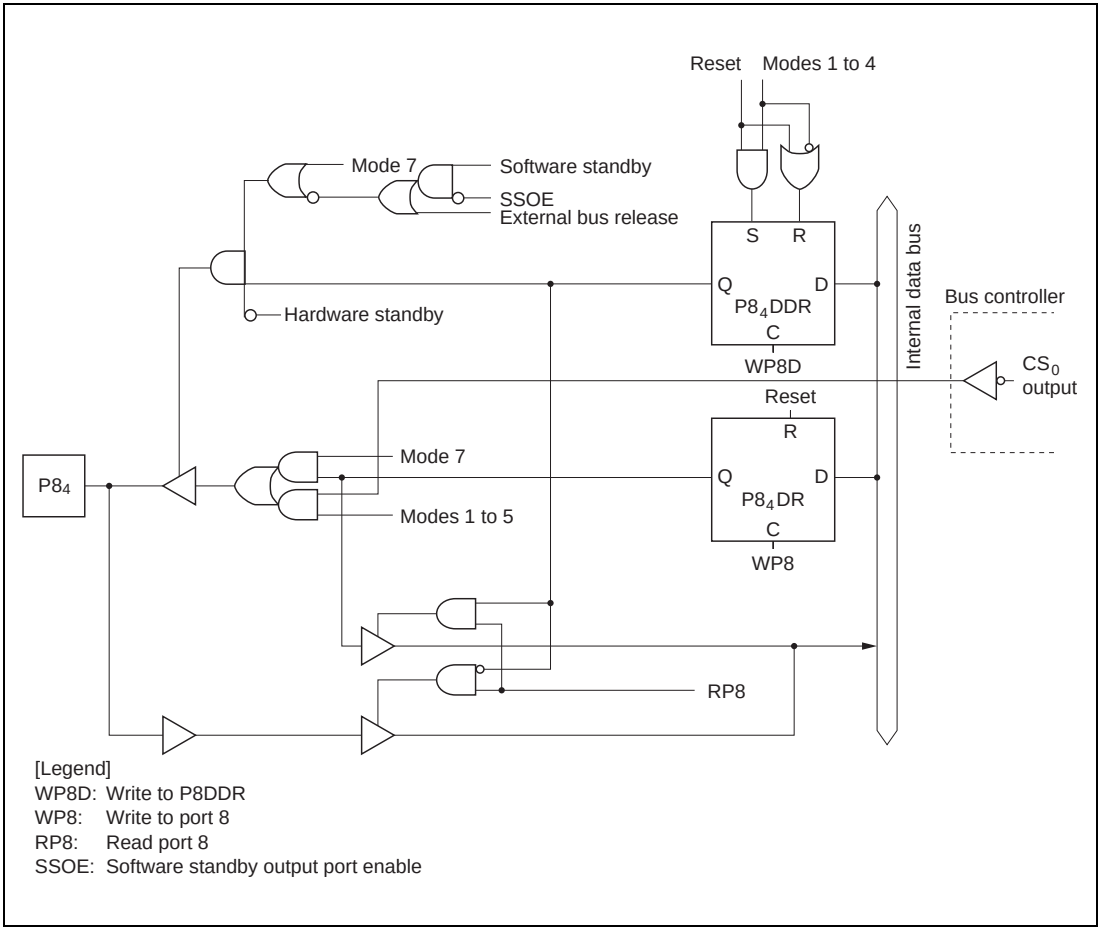


Figure C.8 (e) Port 8 Block Diagram (Pin $P8_4$)

C.9 Port 9 Block Diagrams

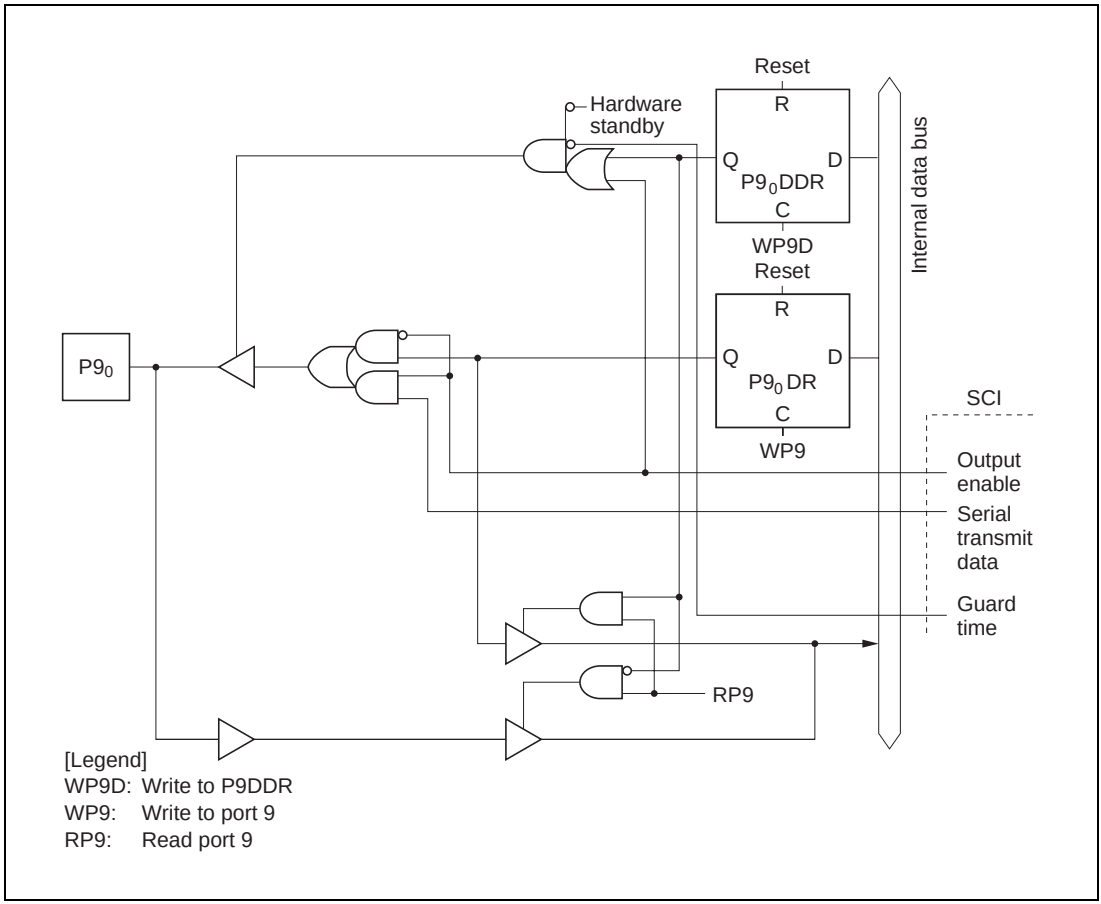


Figure C.9 (a) Port 9 Block Diagram (Pin P9$_0$)

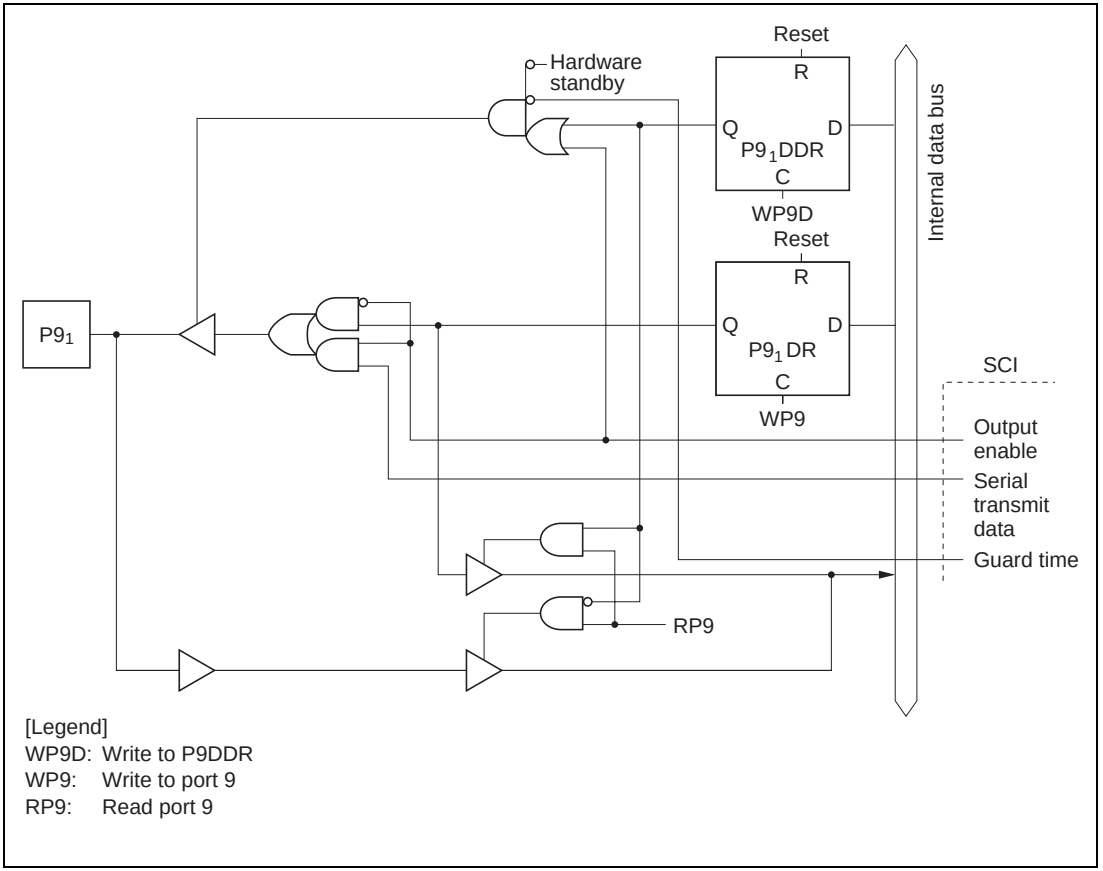


Figure C.9 (b) Port 9 Block Diagram (Pin $P9_1$)

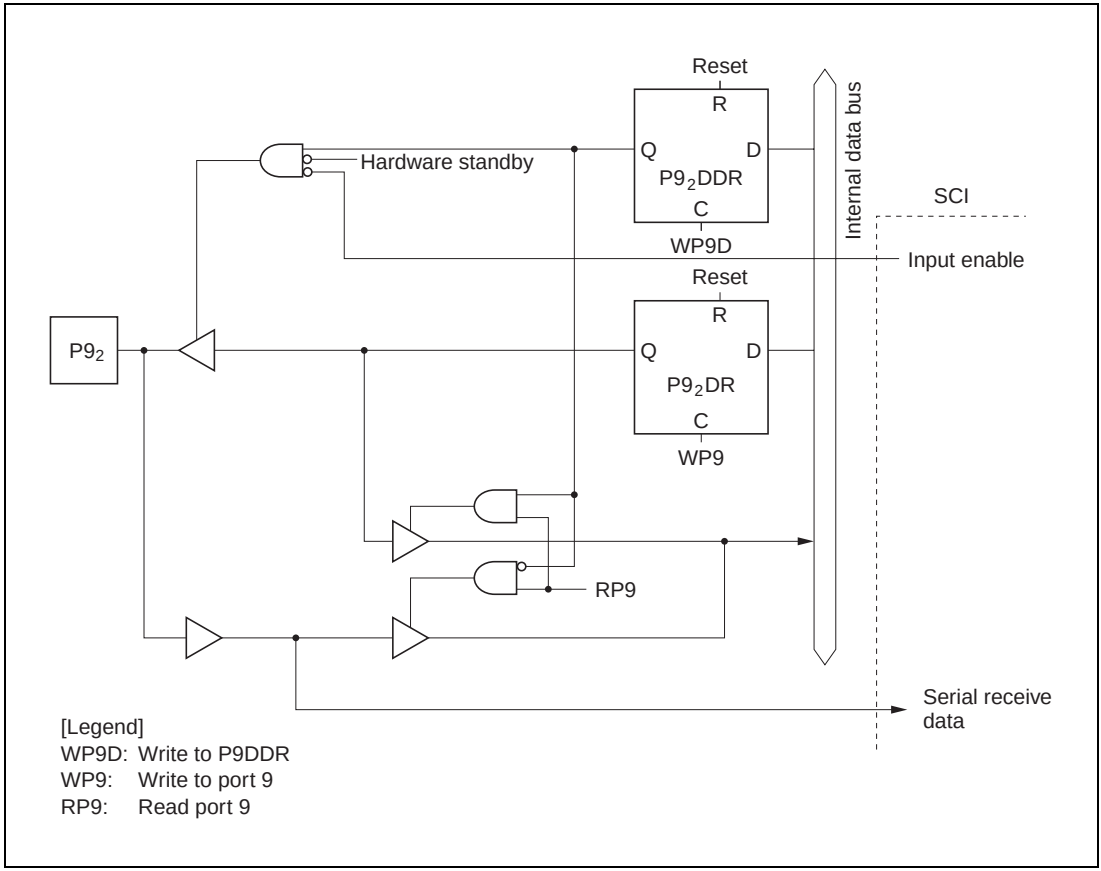


Figure C.9 (c) Port 9 Block Diagram (Pin P9$_2$)

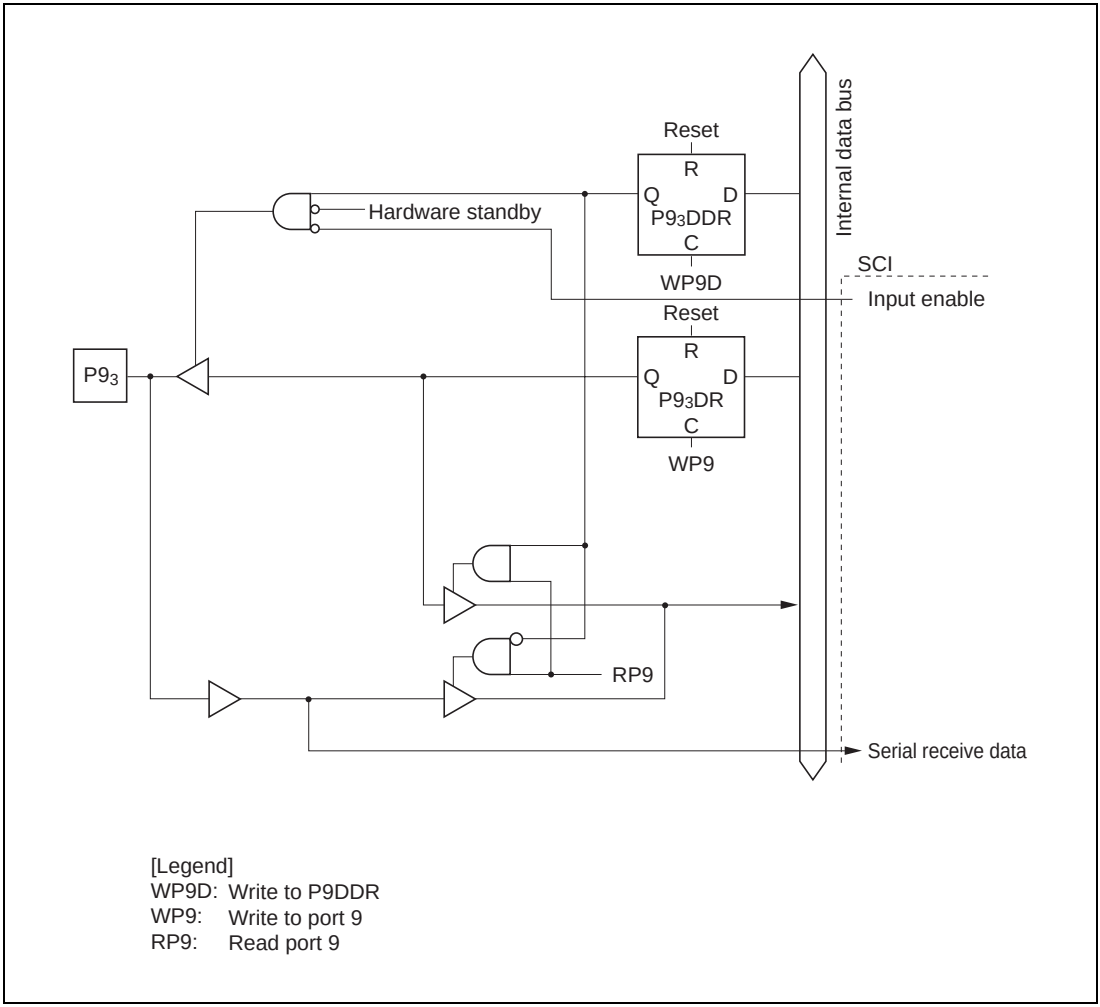


Figure C.9 (d) Port 9 Block Diagram (Pin $P9_3$)

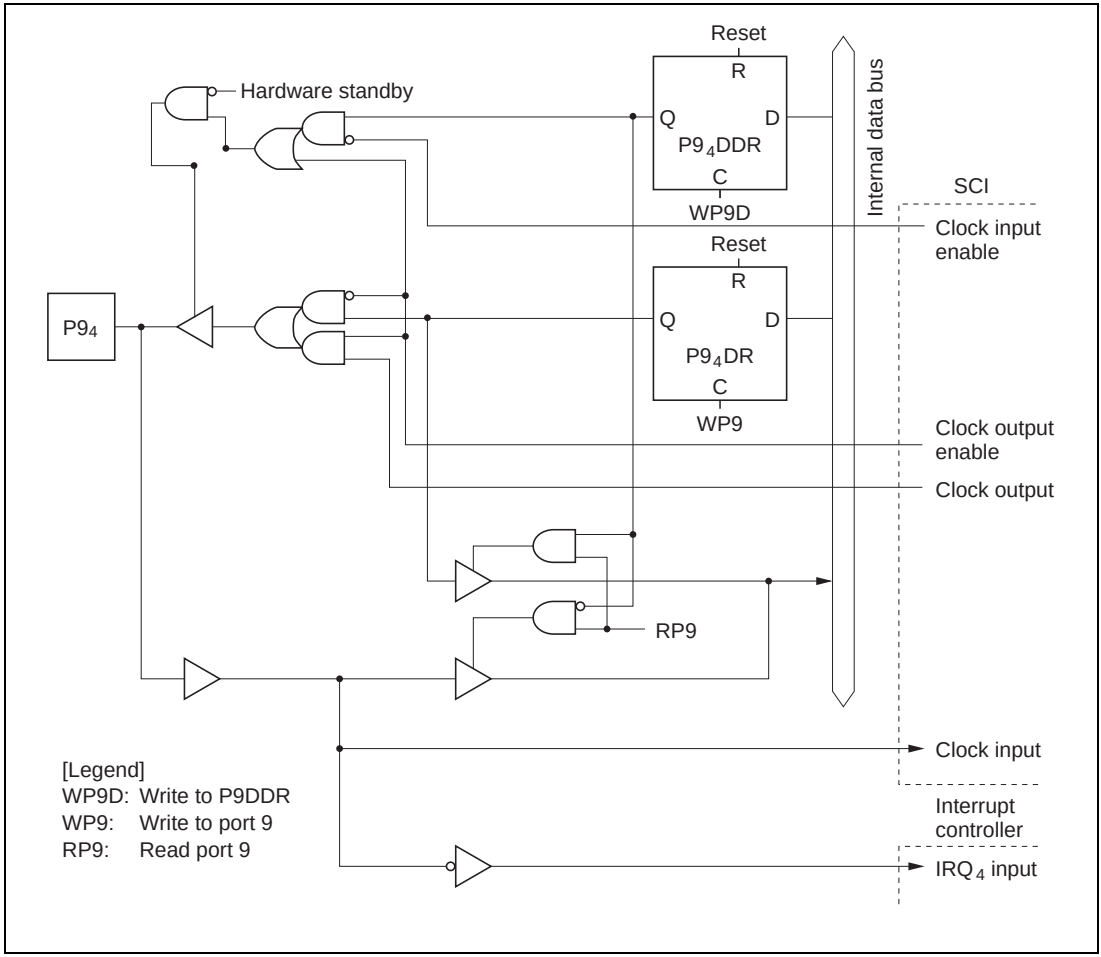


Figure C.9 (e) Port 9 Block Diagram (Pin $P9_4$)

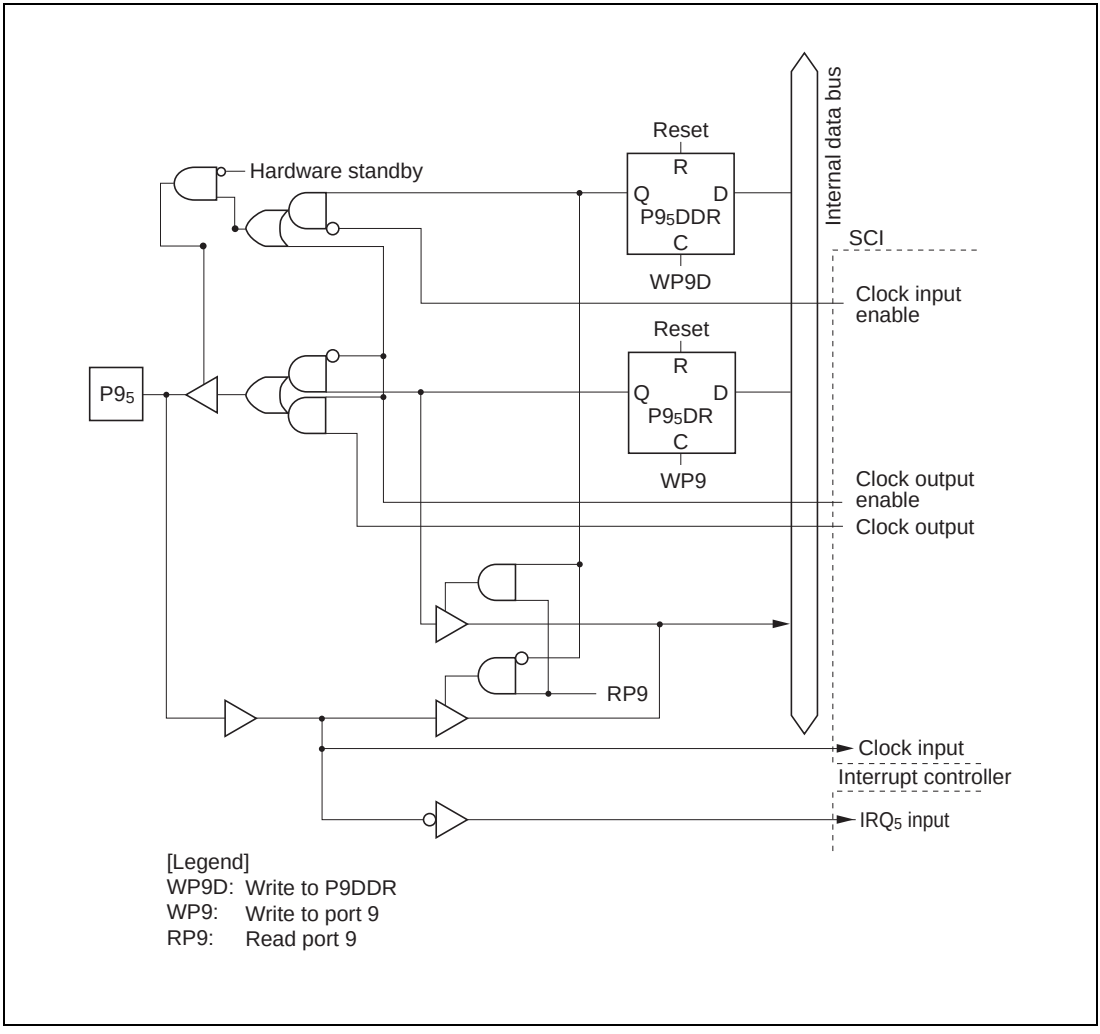


Figure C.9 (f) Port 9 Block Diagram (Pin $P9_5$)

C.10 Port A Block Diagrams

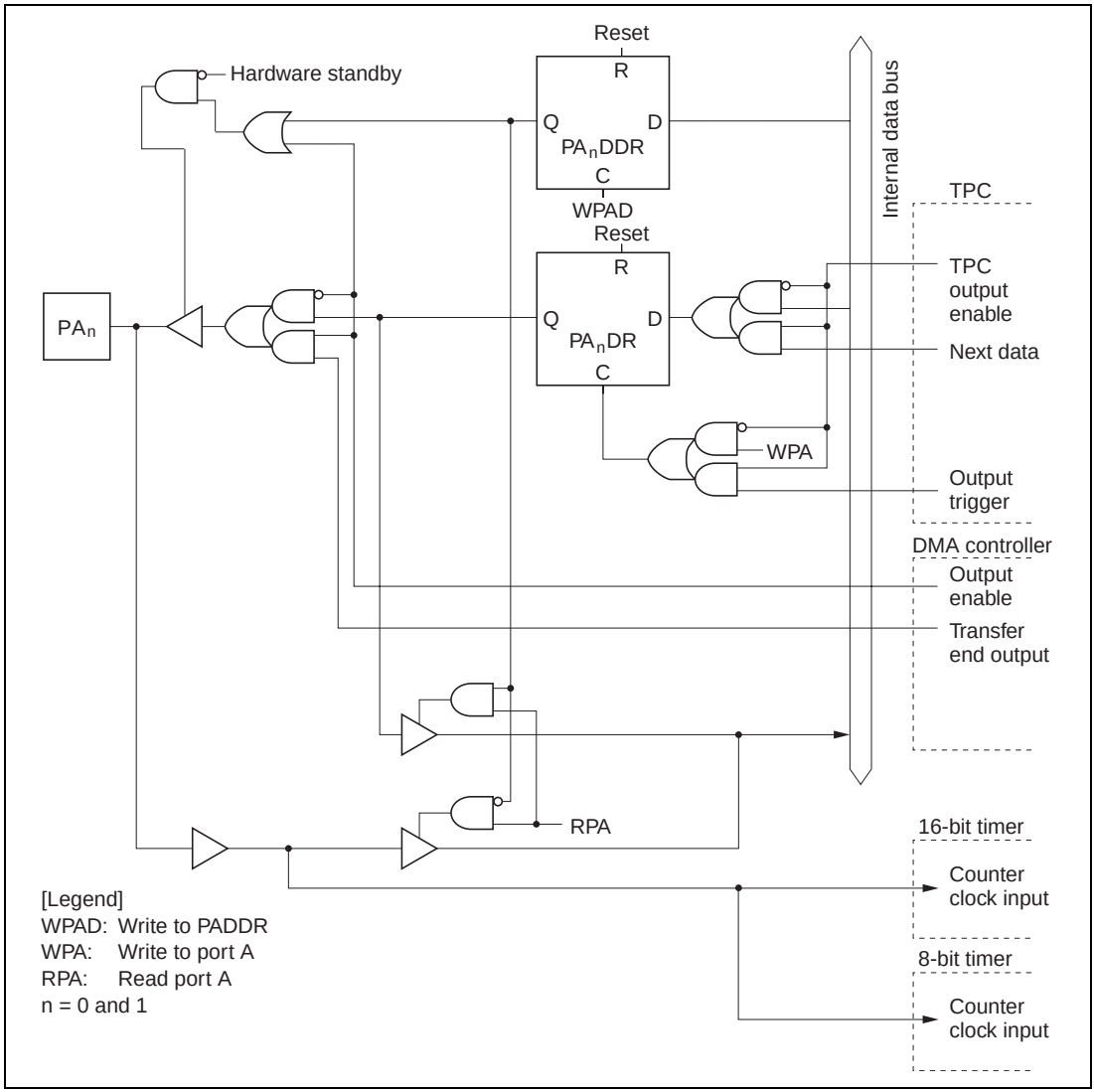


Figure C.10 (a) Port A Block Diagram (Pins PA_0, PA_1)

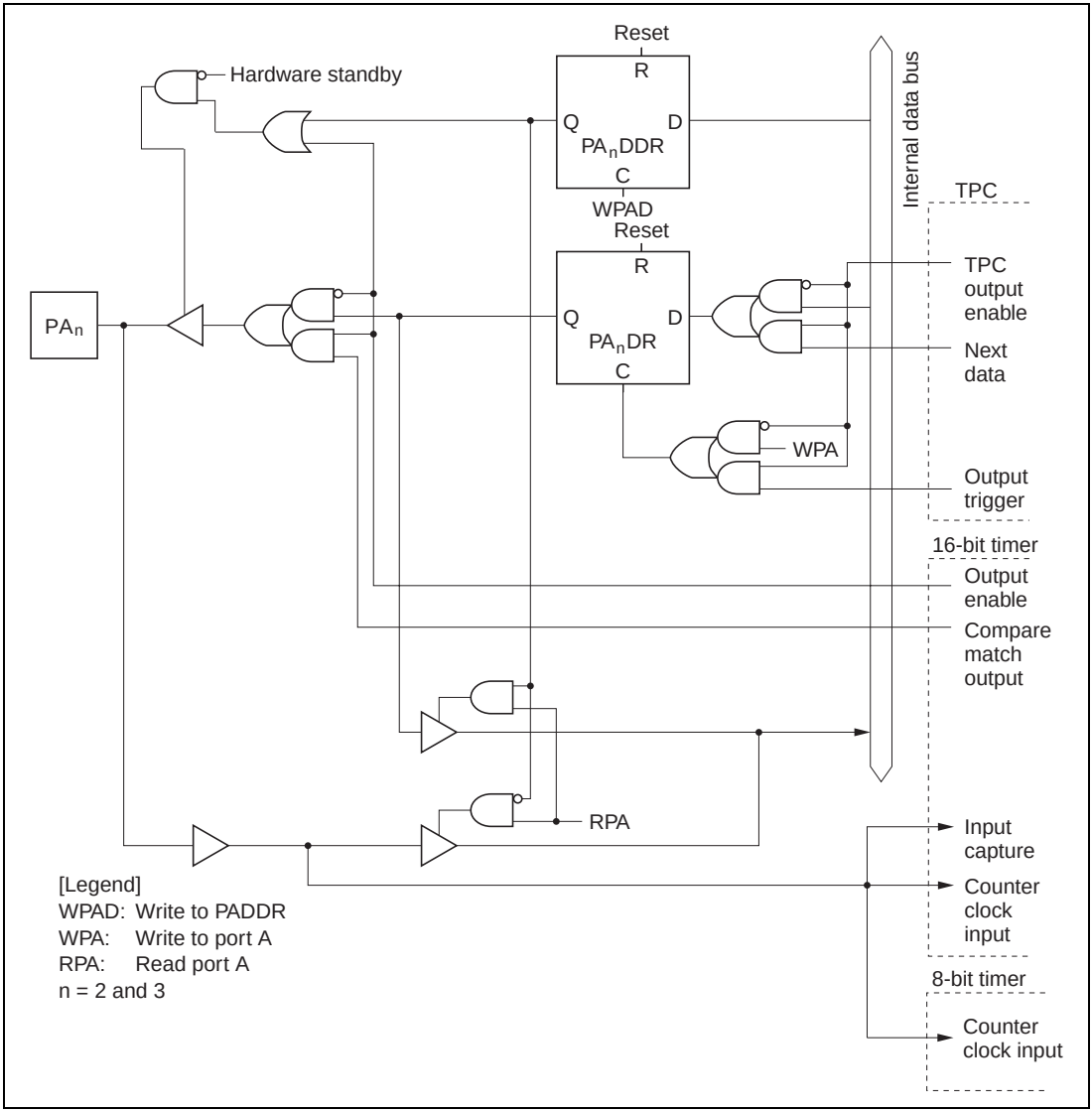
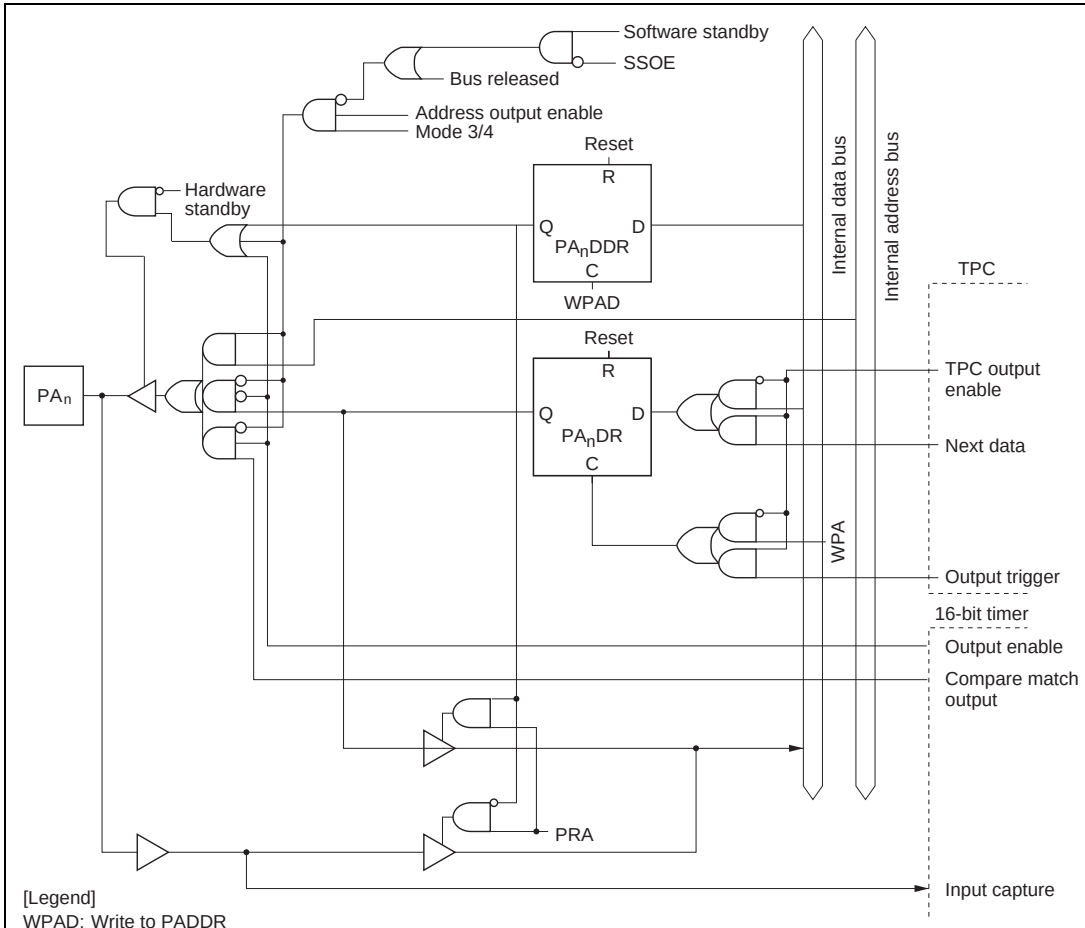


Figure C.10 (b) Port A Block Diagram (Pins PA_2, PA_3)



[Legend]
WPAD: Write to PADDR
WPA: Write to port A
RPA: Read port A
SSOE: Software standby output port enable
n = 4 to 7

Note: The PA_7 address output enable setting is fixed at 1 in modes 3 and 4.

Figure C.10 (c) Port A Block Diagram (Pins PA_4 to PA_7)

C.11 Port B Block Diagrams

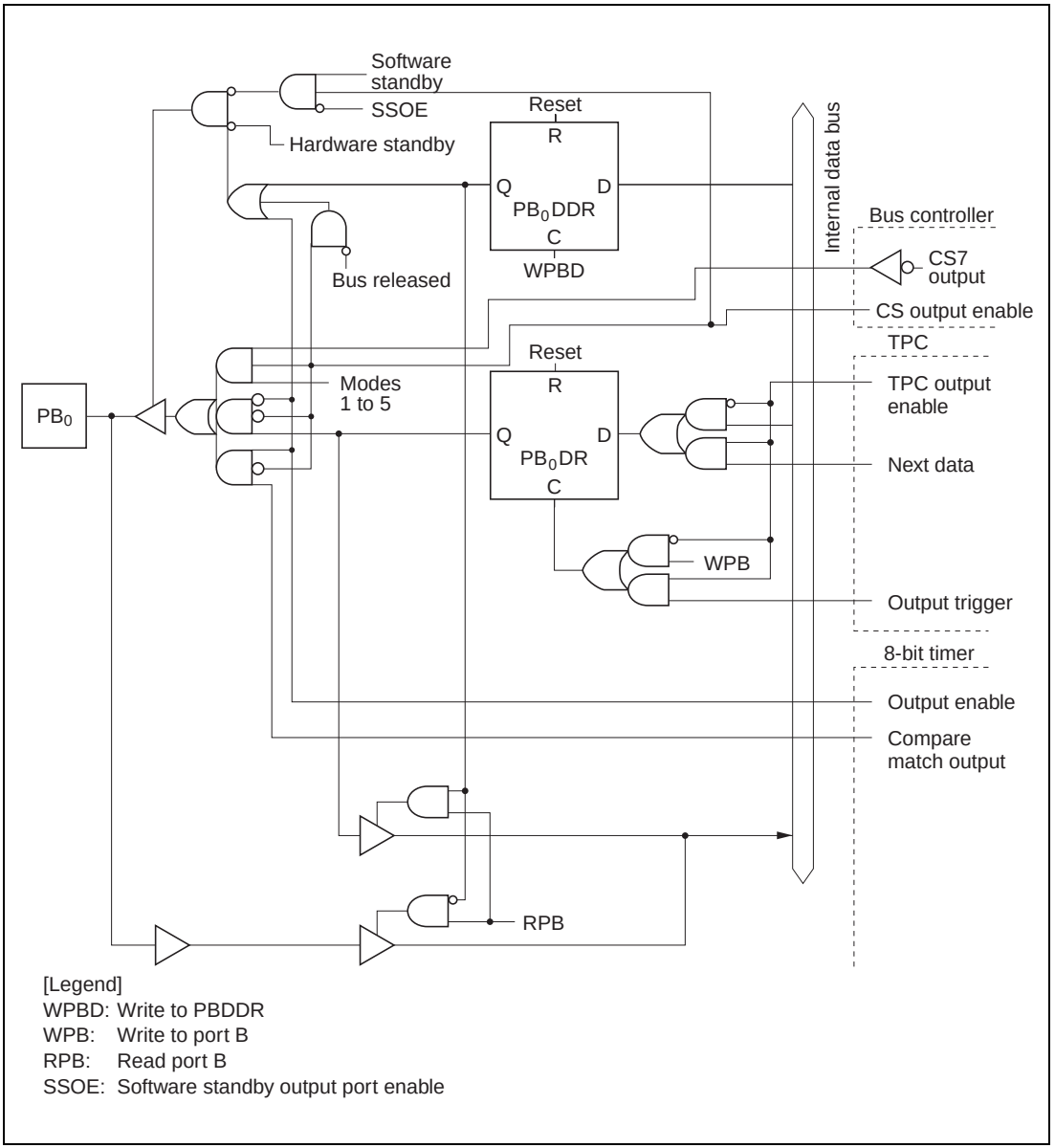


Figure C.11 (a) Port B Block Diagram (Pin PB_0)

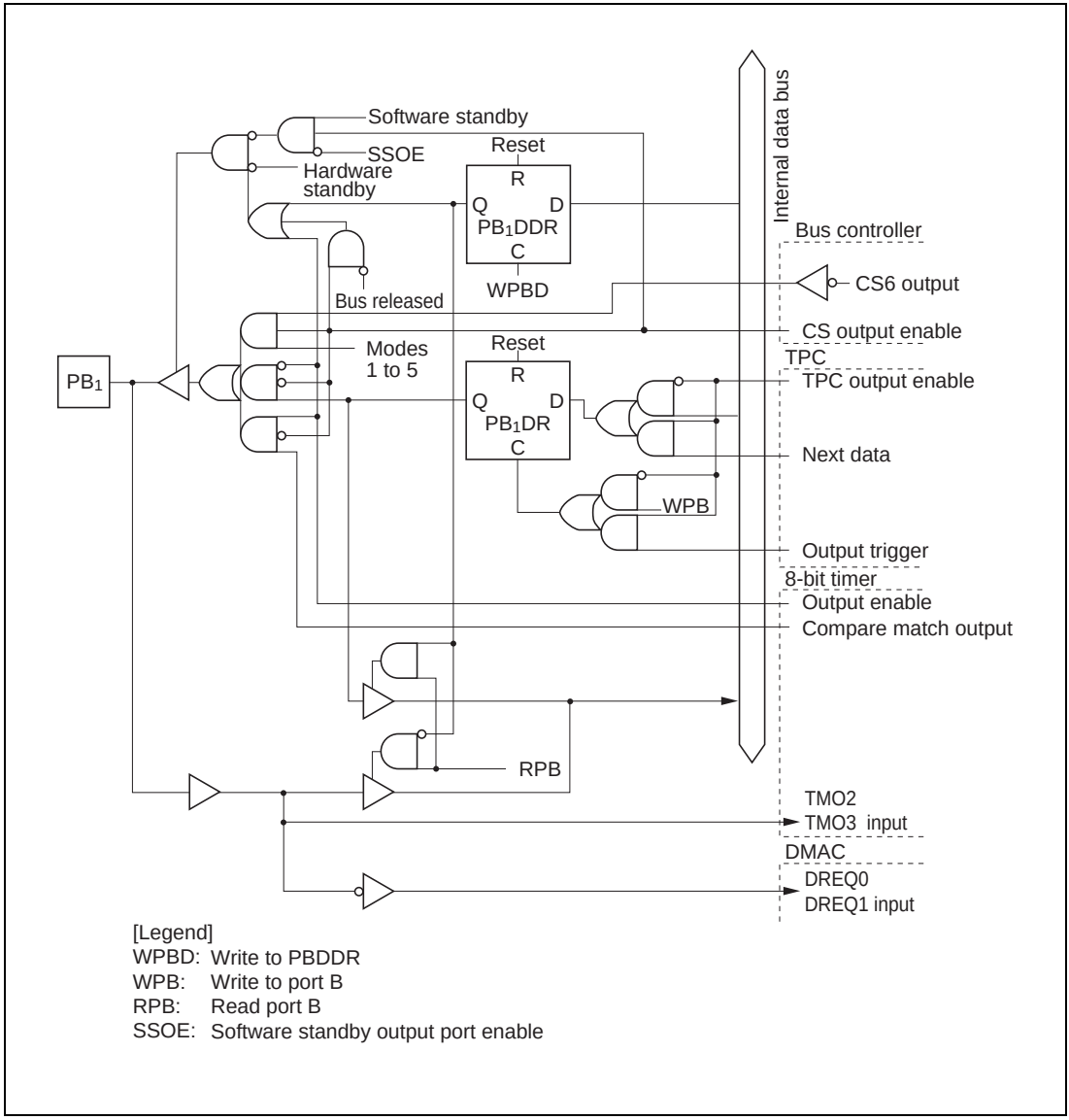
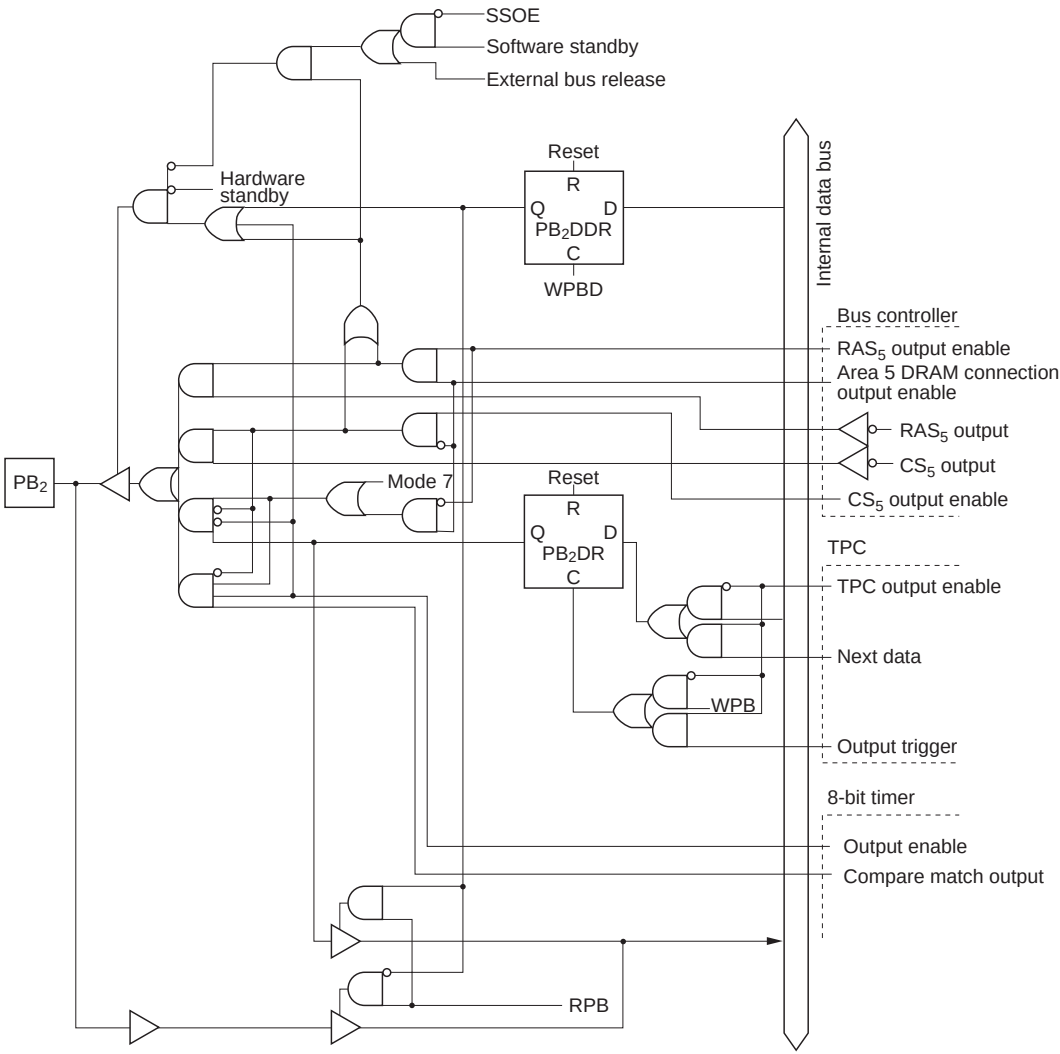


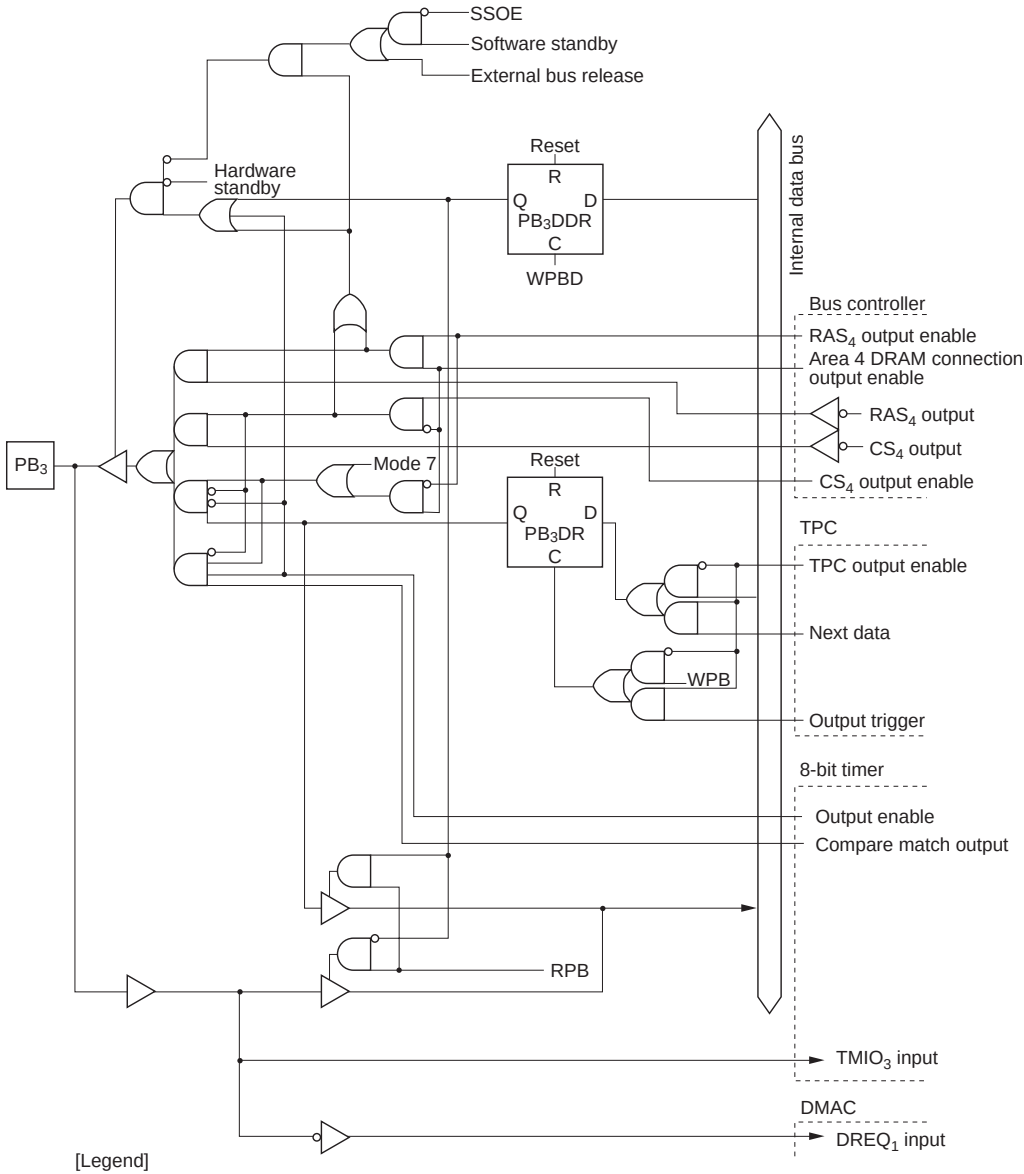
Figure C.11 (b) Port B Block Diagram (Pin PB_1)



[Legend]
WPBD: Write to PBDDR
WPB: Write to port B
RPB: Read port B
SSOE: Software standby output port enable

Note: Area 5 DRAM connection output enable, RAS_5 output enable, and CS_5 output enable are all fixed at 0 in mode 7.

Figure C.11 (c) Port B Block Diagram (Pin PB_2)



[Legend]
WPBD: Write to PBDDR
WPB: Write to port B
RPB: Read port B
SSOE: Software standby output port enable

Note: Area 4 DRAM connection output enable, RAS_4 output enable, and CS_4 output enable are all fixed at 0 in mode 7.

Figure C.11 (d) Port B Block Diagram (Pin PB_3)

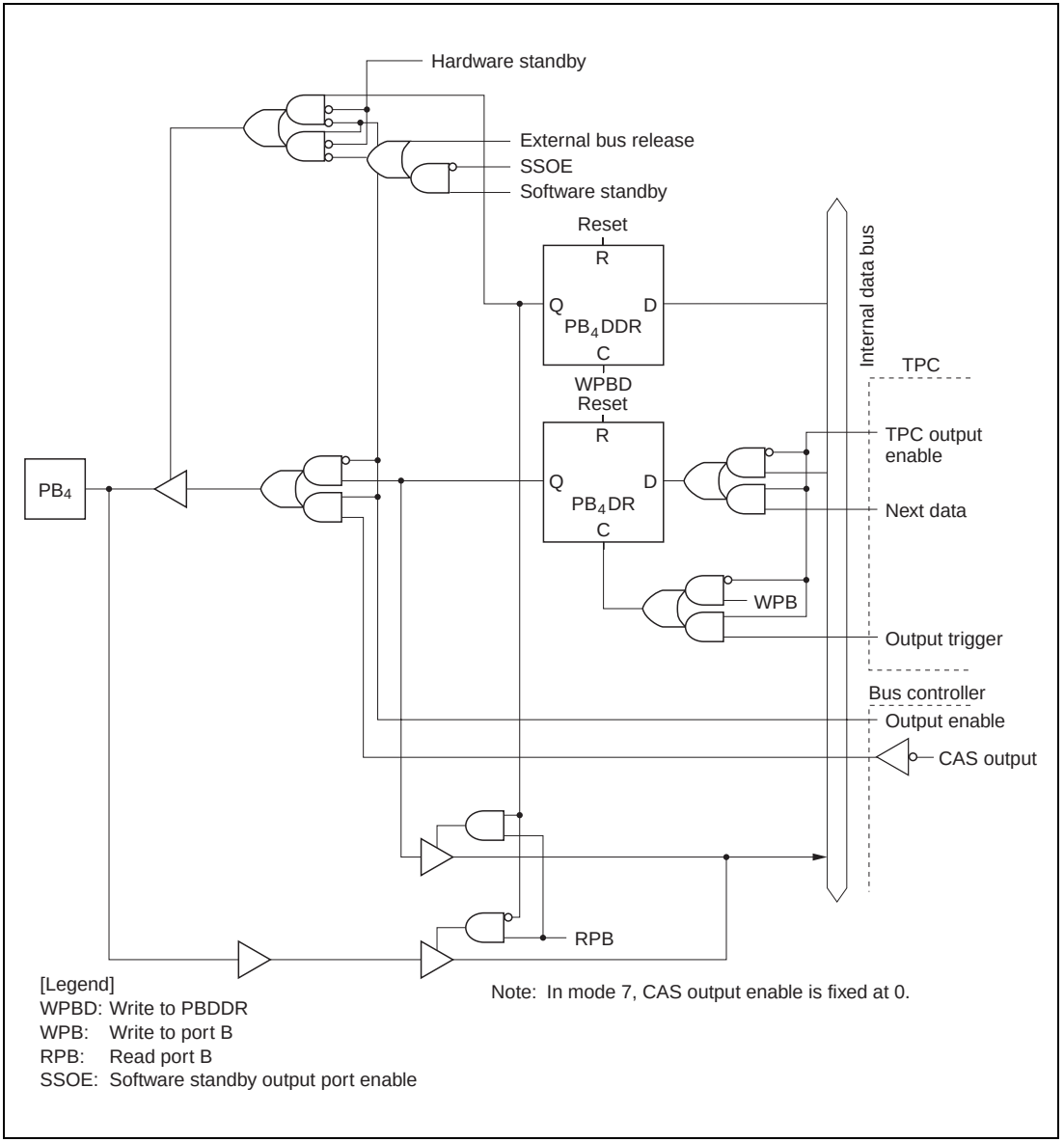
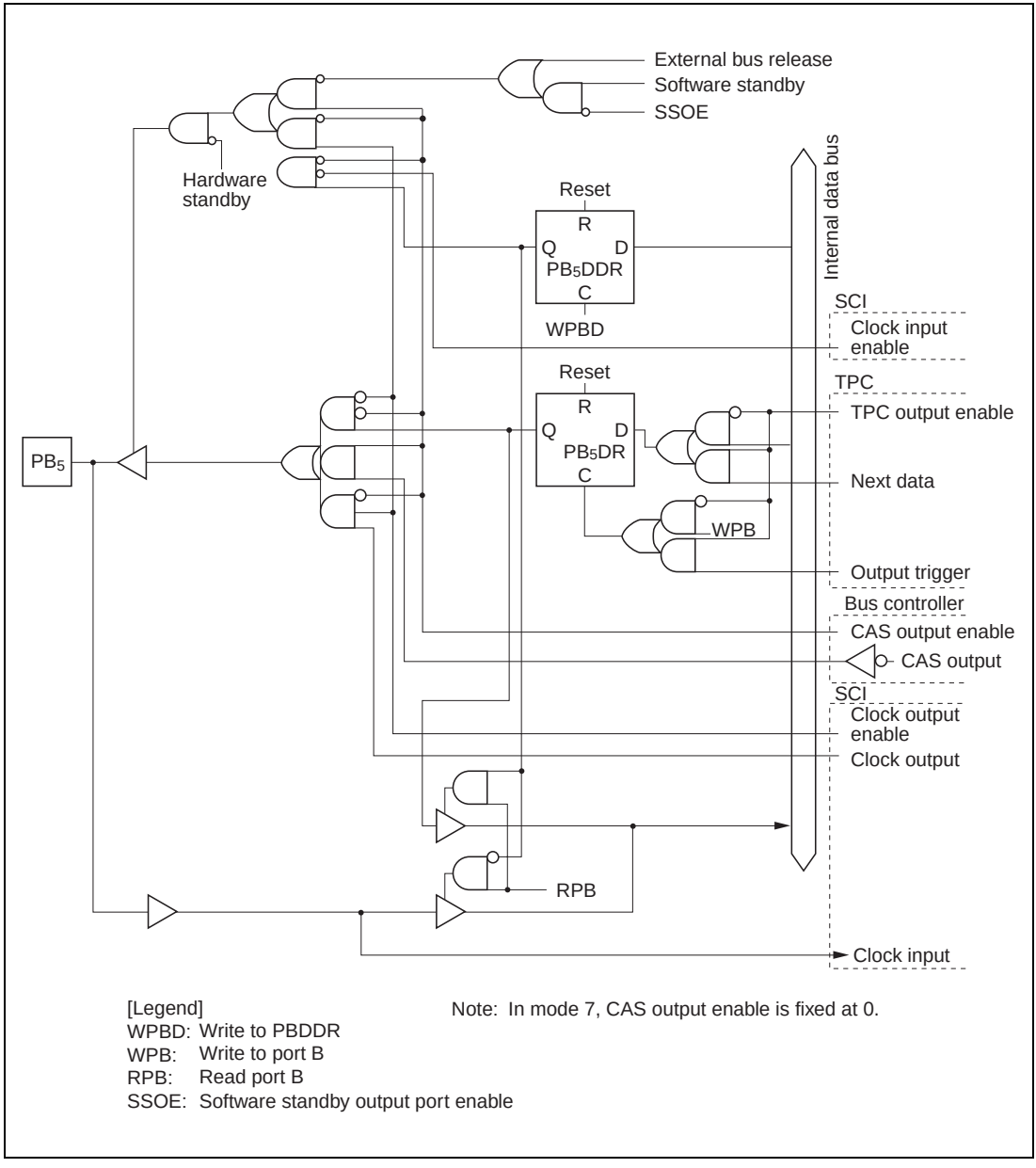


Figure C.11 (e) Port B Block Diagram (Pin PB_4)



[Legend]
WPBD: Write to PBDDR
WPB: Write to port B
RPB: Read port B
SSOE: Software standby output port enable

Note: In mode 7, CAS output enable is fixed at 0.

Figure C.11 (f) Port B Block Diagram (Pin PB_5)

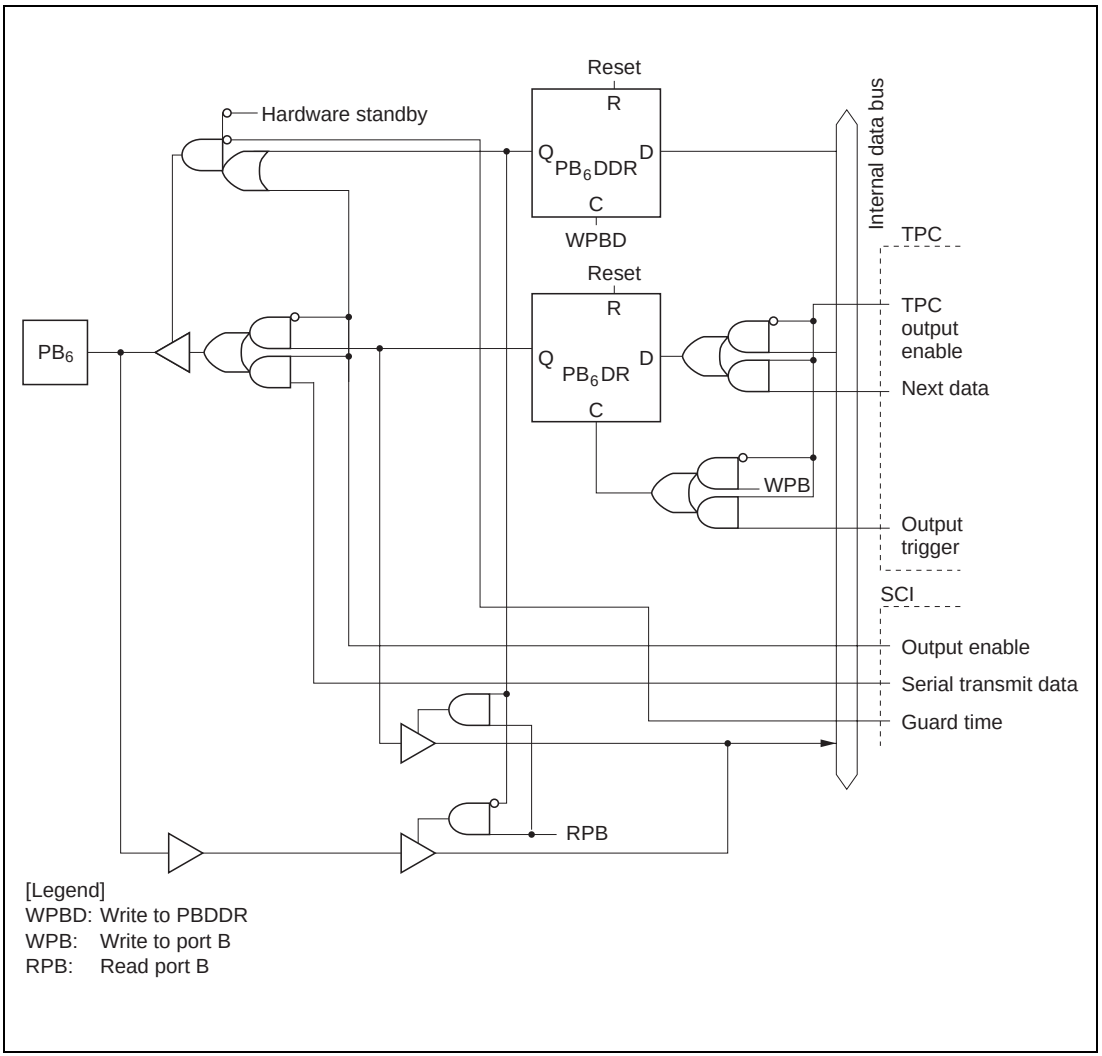


Figure C.11 (g) Port B Block Diagram (Pin PB_6)

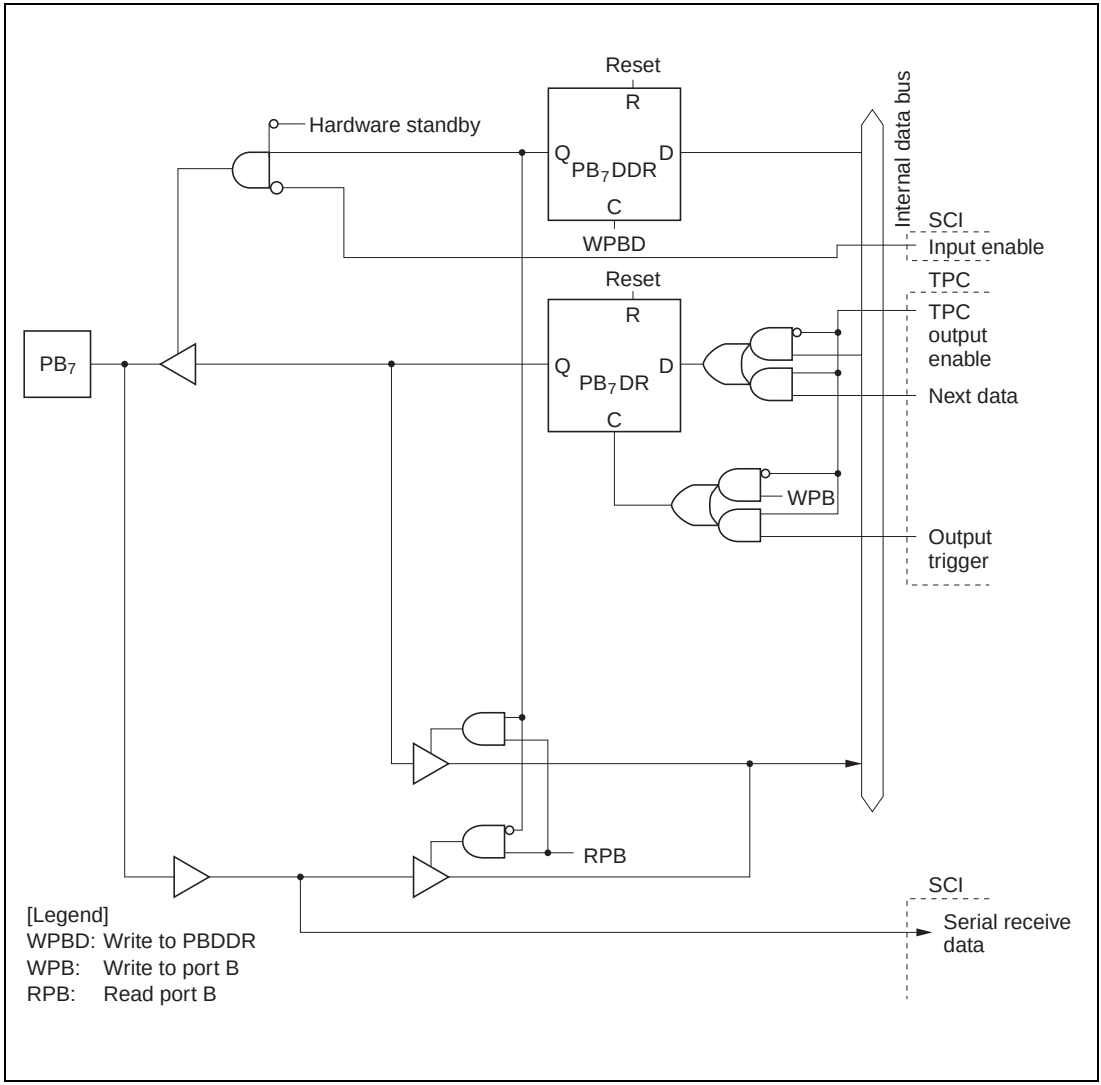


Figure C.11 (h) Port B Block Diagram (Pin PB_7)

Appendix D Pin States

D.1 Port States in Each Mode

Table D.1 Port States

Pin Name	Mode	Reset	Hardware Standby Mode	Software Standby Mode	Bus-Released Mode	Program Execution Mode
$P1_7$ to $P1_0$	1 to 4	L	T	(SSOE=0) T (SSOE=1) Keep	T	A_7 to A_0
	5	T	T	(DDR=0) Keep (DDR=1, SSOE=0) T (DDR=1, SSOE=1) Keep	T	(DDR=0) Input port (DDR=1) A_7 to A_0
	7	T	T	Keep	—	I/O port
$P2_7$ to $P2_0$	1 to 4	L	T	(SSOE=0) T (SSOE=1) Keep	T	A_{15} to A_8
	5	T	T	(DDR=0) Keep (DDR=1,SSOE=0) T (DDR=1,SSOE=1) Keep	T	(DDR=0) Input port (DDR=1) A_{15} to A_8
	7	T	T	Keep	—	I/O port
$P3_7$ to $P3_0$	1 to 5	T	T	T	T	D_{15} to D_8
	7	T	T	Keep	—	I/O port
$P4_7$ to $P4_0$	1, 3, 5	T	T	Keep	Keep	I/O port
	2, 4	T	T	T	T	D_7 to D_0
	7	T	T	Keep	—	I/O port

Pin Name	Mode	Reset	Hardware Standby Mode	Software Standby Mode	Bus-Released Mode	Program Execution Mode
$P5_3$ to $P5_0$	1 to 4	L	T	(SSOE=0) T (SSOE=1) Keep	T	A_{19} to A_{16}
	5	T	T	(DDR=0) Keep (DDR=1, SSOE=0) T (DDR=1, SSOE=1) Keep	T	(DDR=0) Input port (DDR=1) A_{19} to A_{16}
	7	T	T	Keep	—	I/O port
$P6_0$	1 to 5	T	T	Keep	Keep	I/O port $\overline{WAIT}$
	7	T	T	Keep	—	I/O port
$P6_1$	1 to 5	T	T	(BRLE=0) Keep (BRLE=1) T	T	I/O port $\overline{BREQ}$
	7	T	T	Keep	—	I/O port
$P6_2$	1 to 5	T	T	(BRLE=0) Keep (BRLE=1) H	L	(BRLE=0) I/O port (BRLE=1) $\overline{BACK}$
	7	T	T	Keep	—	I/O port
$P6_6$ to $P6_3$	1 to 5	H	T	(SSOE=0) T (SSOE=1) H	T	$\overline{AS}$, $\overline{RD}$, $\overline{HWR}$, $\overline{LWR}$
	7	T	T	Keep	—	I/O port
$P6_7$	1 to 5	Clock output	T	(PSTOP=0) H (PSTOP=1) Keep	(PSTOP=0) ϕ (PSTOP=1) Keep	(PSTOP=0) ϕ (PSTOP=1) Input port
	7	T	T	(PSTOP=0) H (PSTOP=1) Keep	(PSTOP=0) ϕ (PSTOP=1) Keep	(PSTOP=0) ϕ (PSTOP=1) Input port
$P7_7$ to $P7_0$	1 to 5, 7	T	T	T	T	Input port

Pin Name	Mode	Reset	Hardware Standby Mode	Software Standby Mode	Bus-Released Mode	Program Execution Mode
$P8_0$	1 to 5	T	T	When DRAM space is not selected*[1] (RFSHE=0) Keep (RFSHE=1) Illegal setting When DRAM space is selected*[2] (RFSHE=0) Keep (RFSHE=1, SRFMD=0, SSOE=0) T (RFSHE=1, SRFMD=0, SSOE=1) H (RFSHE=1, SRFMD=1) $\overline{RFSH}$	When DRAM space is selected*[1] (RFSHE=0) Keep (RFSHE=1) Illegal setting When DRAM space is selected*[2] (RFSHE=0) Keep (RFSHE=1) T	(RFSHE=0) I/O port (RFSHE=1) $\overline{RFSH}$
	7	T	T	Keep	—	I/O port
$P8_1$	1 to 5	T	T	When DRAM space is selected and RAS_3 is output*[3] (SSOE=0) T (SSOE=1) H When DRAM space is selected and RAS_3 is not output*[4] Keep Otherwise*[5] *[1] (DDR=0) T (DDR=1, SSOE=0) T (DDR=1, SSOE=1) H	When DRAM space is selected and RAS_3 is output*[3] T When DRAM space is selected and RAS_3 is not output *[4] Keep Otherwise*[1] (DDR=0) Keep (DDR=1) T	When DRAM space is selected and RAS_3 is output $\overline{RAS}_3$ When DRAM space is selected and RAS_3 is not output I/O port Otherwise (DDR=0) Input port (DDR=1) $\overline{CS}_3$
	7	T	T	Keep	—	I/O port

Pin Name	Mode	Reset	Hardware Standby Mode	Software Standby Mode	Bus-Released Mode	Program Execution Mode
$P8_2$	1 to 5	T	T	RAS_2 output*2 (SSOE=0) T (SSOE=1) H Otherwise*1 (DDR=0) T (DDR=1, SSOE=0) T (DDR=1, SSOE=1) H	RAS_2 output*2 T Otherwise*1 (DDR=0) Keep (DDR=1) T	RAS_2 output $\overline{RAS}_2$ Otherwise (DDR=0) I/O port (DDR=1) $\overline{CS}_2$
	7	T	T	Keep	—	I/O port
$P8_3$	1 to 5	T	T	(DDR=0) T (DDR=1, SSOE=0) T (DDR=1, SSOE=1) H	(DDR=0) Keep (DDR=1) T	(DDR=0) Input port (DDR=1) $\overline{CS}_1$
	7	T	T	Keep	—	I/O port
$P8_4$	1 to 4	H	T	(DDR=0) T (DDR=1, SSOE=0) T (DDR=1, SSOE=1) H	(DDR=0) Keep (DDR=1) T	(DDR=0) Input port (DDR=1) $\overline{CS}_0$
	5	T	T	(DDR=0) T (DDR=1, SSOE=0) T (DDR=1, SSOE=1) H	(DDR=0) Keep (DDR=1) T	(DDR=0) Input port (DDR=1) $\overline{CS}_0$
	7	T	T	Keep	—	I/O port
$P9_5$ to $P9_0$	1 to 5, 7	T	T	Keep	Keep	I/O port
PA_3 to PA_0	1 to 5, 7	T	T	Keep	Keep	I/O port
PA_6 to PA_4	1, 2, 7	T	T	Keep	Keep	I/O port

Pin Name	Mode	Reset	Hardware Standby Mode	Software Standby Mode	Bus-Released Mode	Program Execution Mode
PA_6 to PA_4	3 to 5	T	T	Address output*[5] (SSOE=0) T (SSOE=1) Keep Otherwise*[6] Keep	Address output*[5] T Otherwise*[6] Keep	Address output A_{23} to A_{21} Otherwise I/O port
PA_7	1, 2	T	T	Keep	Keep	I/O port
	3, 4	L	T	(SSOE=0) T (SSOE=1) Keep	T	A_{20}
	5	L	T	When A20E=0 SSOE=0 T SSOE=1 Keep When A20E=1 Keep	When A20E=0 T When A20E=1 Keep	When A20E=0 A_{20} When A20E=1 I/O port
	7	T	T	Keep	—	I/O port
PB_1, PB_0	1 to 5	T	T	CS output*[7] (SSOE=0) T (SSOE=1) H Otherwise*[8] Keep	CS output*[7] T Otherwise*[8] Keep	CS output $\overline{CS}_7$, $\overline{CS}_6$ Otherwise I/O port
	7	T	T	Keep	—	I/O port
PB_2	1 to 5	T	T	RAS_5 output*[9] (SSOE=0) T (SSOE=1) H CS output*[10] (SSOE=0) T (SSOE=1) H Otherwise*[11] Keep	RAS_5 output*[9] T CS output*[10] T Otherwise*[11] Keep	RAS_5 output $\overline{RAS}_5$ CS output $\overline{CS}_5$ Otherwise I/O port
	7	T	T	Keep	—	I/O port

Pin Name	Mode	Reset	Hardware Standby Mode	Software Standby Mode	Bus-Released Mode	Program Execution Mode
PB_3	1 to 5	T	T	RAS_4 output*[12] (SSOE=0) T (SSOE=1) H CS output*[13] (SSOE=0) T (SSOE=1) H Otherwise*[14] Keep	RAS_4 output*[12] T CS output*[13] T Otherwise*[14] Keep	RAS_4 output $\overline{RAS}_4$ CS output $\overline{CS}_4$ Otherwise I/O port
	7	T	T	Keep	—	I/O port
PB_5, PB_4	1 to 5	T	T	CAS output*[15] (SSOE=0) T (SSOE=1) H Otherwise*[16] Keep	CAS output*[15] T Otherwise*[16] Keep	CAS output $\overline{UCAS}$, $\overline{LCAS}$ Otherwise I/O port
	7	T	T	Keep	—	I/O port
PB_7, PB_6	1 to 5, 7	T	T	Keep	Keep	I/O port

[Legend]

H: High

L: Low

T: High-impedance state

Keep: Input pins are in the high-impedance state; output pins maintain their previous state.

DDR: Data direction register

Notes:
1. When bits DRAS2, DRAS1, and DRAS0 in DRCRA (DRAM control register A) are all cleared to 0.
2. When any of bits DRAS2, DRAS1, or DRAS0 in DRCRA (DRAM control register A) is set to 1.
3. When the setting of bits DRAS2, DRAS1, and DRAS0 in DRCRA (DRAM control register A) is 010, 100, or 101.
4. When the setting of bits DRAS2, DRAS1, and DRAS0 in DRCRA (DRAM control register A) is other than 010, 100, 101, or 000.
5. When bit A23E, A22E, or A21E, respectively, in BRCR (bus release control register) is cleared to 0.
6. When bit A23E, A22E, or A21E, respectively, in BRCR (bus release control register) is set to 1.
7. When bit CS7E or CS6E, respectively, in CSCR (chip select control register) is set to 1.
8. When bit CS7E or CS6E, respectively, in CSCR (chip select control register) is cleared to 0.

9. When the setting of bits DRAS2, DRAS1, and DRAS0 in DRCRA (DRAM control register A) is 101.
10. When the setting of bits DRAS2, DRAS1, and DRAS0 in DRCRA (DRAM control register A) is other than 101, and bit CS5E in CSCR (chip select control register) is set to 1.
11. When the setting of bits DRAS2, DRAS1, and DRAS0 in DRCRA (DRAM control register A) is other than 101, and bit CS5E in CSCR (chip select control register) is cleared to 0.
12. When the setting of bits DRAS2, DRAS1, and DRAS0 in DRCRA (DRAM control register A) is 100, 101, or 110.
13. When the setting of bits DRAS2, DRAS1, and DRAS0 in DRCRA (DRAM control register A) is other than 100, 101, or 110, and bit CS4E in CSCR (chip select control register) is set to 1.
14. When the setting of bits DRAS2, DRAS1, and DRAS0 in DRCRA (DRAM control register A) is other than 100, 101, or 110, and bit CS4E in CSCR (chip select control register) is cleared to 0.
15. When any of bits DRAS2, DRAS1, or DRAS0 in DRCRA (DRAM control register A) is set to 1, and bit CSEL in DRCRB (DRAM control register B) is cleared to 0.
16. When any of bits DRAS2, DRAS1, or DRAS0 in DRCRA (DRAM control register A) is set to 1, and bit CSEL in DRCRB (DRAM control register B) is set to 1; or, when bits DRAS2, DRAS1, and DRAS0 are all cleared to 0.

D.2 Pin States at Reset

Modes 1 and 2: Figure D.1 is a timing diagram for the case in which $\overline{RES}$ goes low during an external memory access in mode 1 or 2. As soon as $\overline{RES}$ goes low, all ports are initialized to the input state. $\overline{AS}$, $\overline{RD}$, $\overline{HWR}$, $\overline{LWR}$, and $\overline{CS}_0$ go high, and D_{15} to D_0 go to the high-impedance state. The address bus is initialized to the low output level 2.5 ϕ clock cycles after the low level of $\overline{RES}$ is sampled. Clock pin $P6_7/\phi$ goes to the output state at the next rise of ϕ after $\overline{RES}$ goes low.

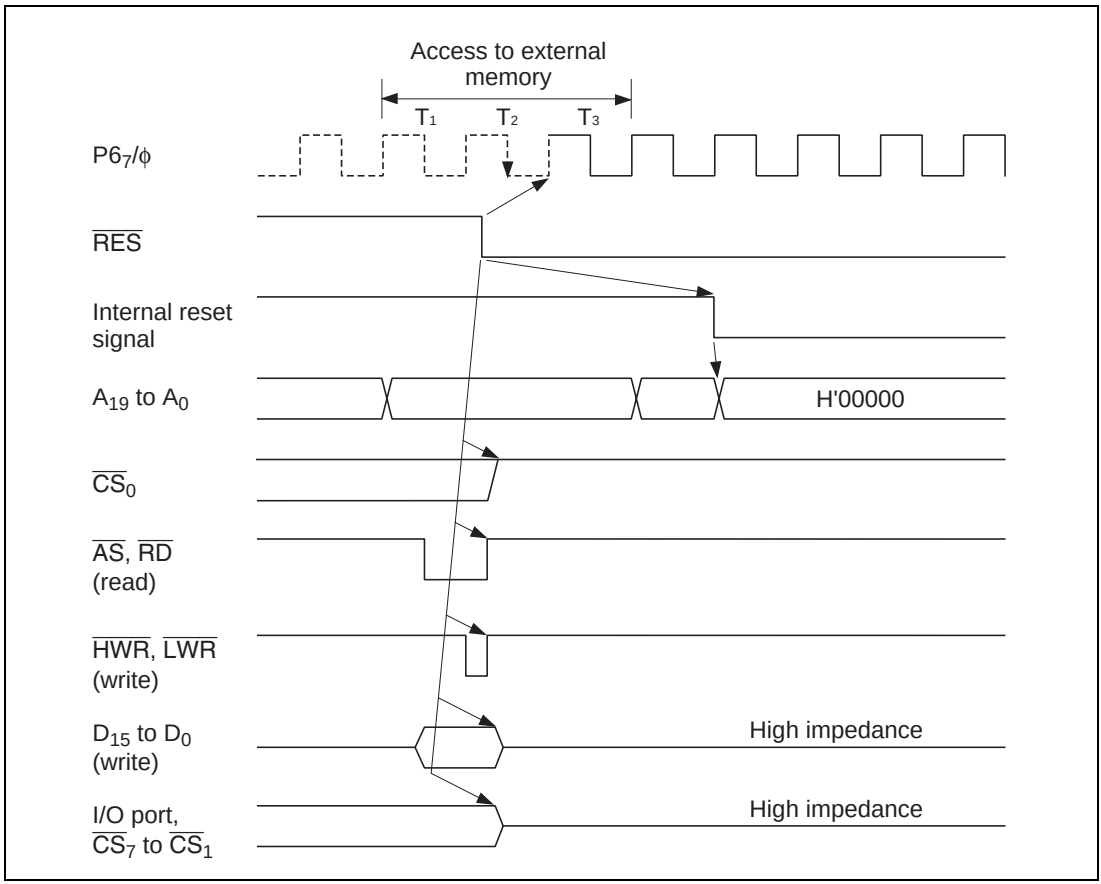


Figure D.1 Reset during Memory Access (Modes 1 and 2)

Modes 3 and 4: Figure D.2 is a timing diagram for the case in which $\overline{RES}$ goes low during an external memory access in mode 3 or 4. As soon as $\overline{RES}$ goes low, all ports are initialized to the input state. $\overline{AS}$, $\overline{RD}$, $\overline{HWR}$, $\overline{LWR}$, and $\overline{CS}_0$ go high, and D_{15} to D_0 go to the high-impedance state. The address bus is initialized to the low output level 2.5 ϕ clock cycles after the low level of $\overline{RES}$ is sampled. However, when PA_4 to PA_6 are used as address bus pins, or when $P8_3$ to $P8_1$ and PB_0 to PB_3 are used as CS output pins, they go to the high-impedance state at the same time as $\overline{RES}$ goes low. Clock pin $P6_7/\phi$ goes to the output state at the next rise of ϕ after $\overline{RES}$ goes low.

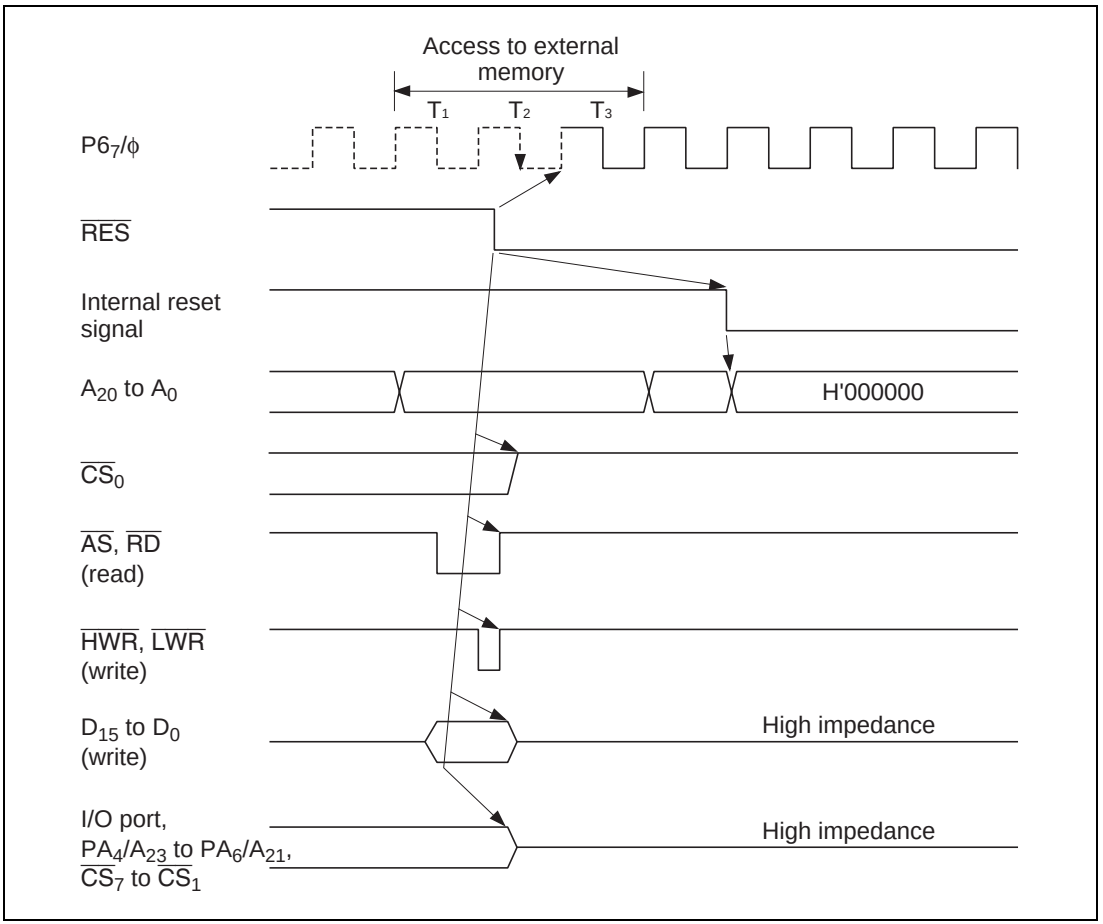


Figure D.2 Reset during Memory Access (Modes 3 and 4)

Mode 5: Figure D.3 is a timing diagram for the case in which $\overline{RES}$ goes low during an external memory access in mode 5. As soon as $\overline{RES}$ goes low, all ports are initialized to the input state. $\overline{AS}$, $\overline{RD}$, $\overline{HWR}$, and $\overline{LWR}$ go high, and the address bus and D_{15} to D_0 go to the high-impedance state. Clock pin $P6_7/\phi$ goes to the output state at the next rise of ϕ after $\overline{RES}$ goes low.

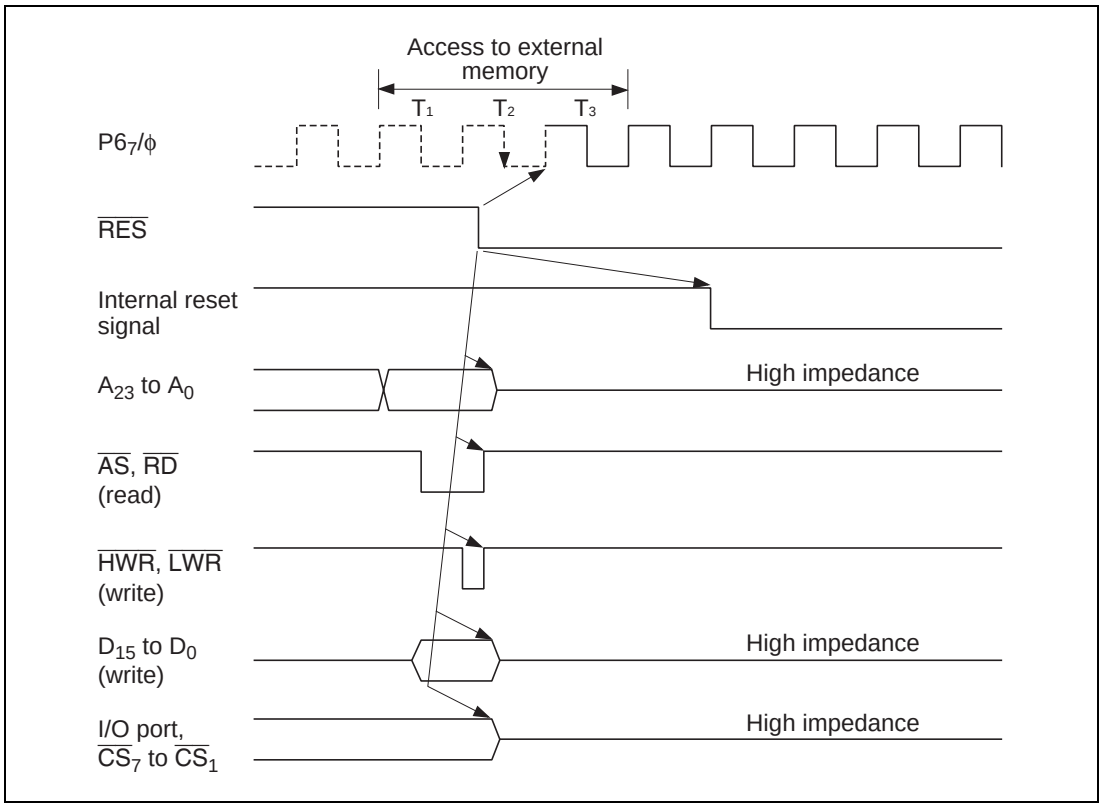


Figure D.3 Reset during Memory Access (Mode 5)

Mode 7: Figure D.4 is a timing diagram for the case in which $\overline{RES}$ goes low during an operation in mode 7. As soon as $\overline{RES}$ goes low, all ports and clock pin $P6_7/\phi$ are initialized to the input state.

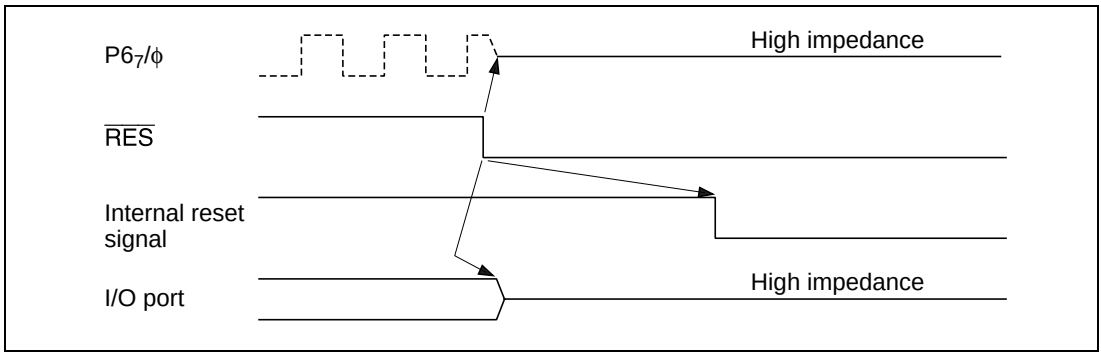
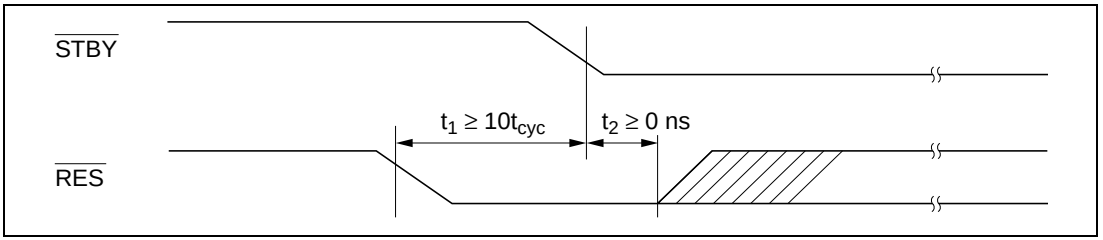


Figure D.4 Reset during Operation (Mode 7)

Appendix E Timing of Transition to and Recovery from Hardware Standby Mode

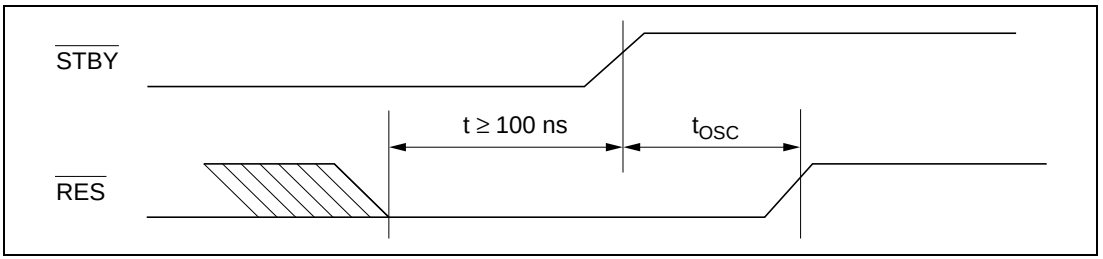
Timing of Transition to Hardware Standby Mode

1. To retain RAM contents with the RAME bit set to 1 in SYSCR, drive the $\overline{\text{RES}}$ signal low 10 system clock cycles before the $\overline{\text{STBY}}$ signal goes low, as shown below. $\overline{\text{RES}}$ must remain low until $\overline{\text{STBY}}$ goes low (minimum delay from $\overline{\text{STBY}}$ low to $\overline{\text{RES}}$ high: 0 ns).



2. To retain RAM contents with the RAME bit cleared to 0 in SYSCR, $\overline{\text{RES}}$ does not have to be driven low as in (1).

Timing of Recovery from Hardware Standby Mode: Drive the $\overline{\text{RES}}$ signal low approximately 100 ns before $\overline{\text{STBY}}$ goes high.



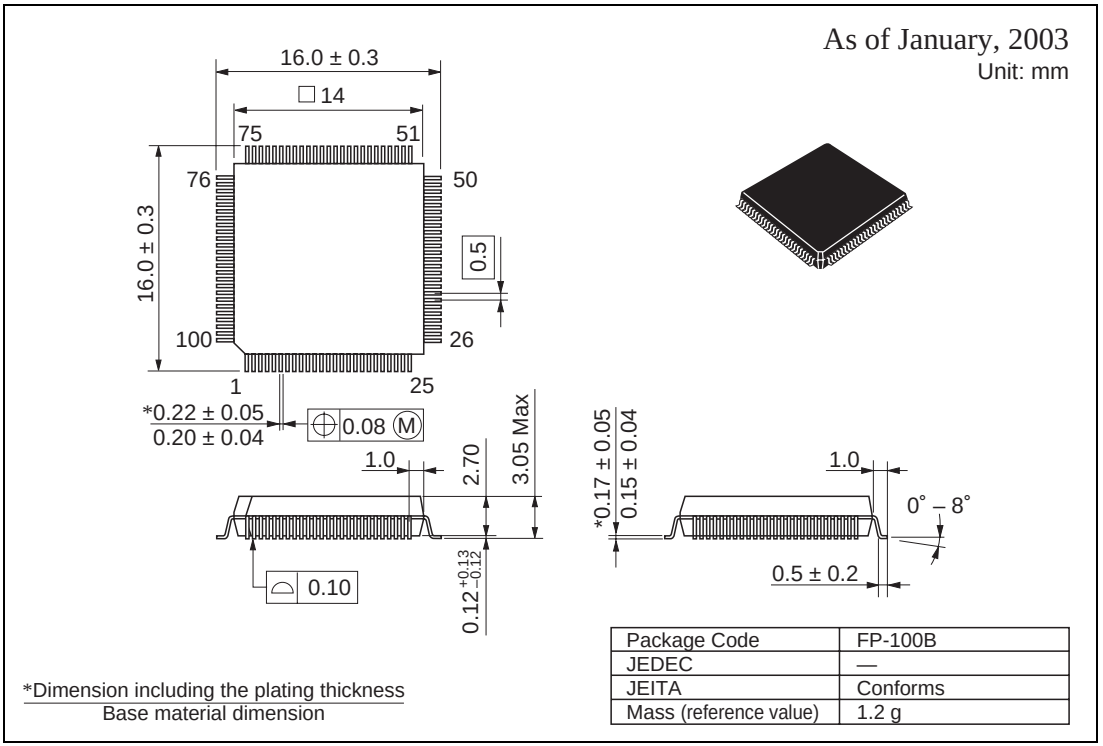
Appendix F Product Code Lineup

F.1 H8/3069R Product Code Lineup

Product Type		Product Code (Catalog Product Code)	Regular product code (Internal Product Code)	Package (Package Code)
H8/3069R	On-chip flash memory	HD64F3069RF25	HD64F3069RF25	100-pin QFP (FP-100B)
		HD64F3069RF25W	HD64F3069RF25W	
		HD64F3069RFBL25	HD64F3069RFBL25	
		HD64F3069RTE25	HD64F3069RX25	100-pin TQFP (TFP-100B)
		HD64F3069RTE25W	HD64F3069RX25W	
		HD64F3069RTEBL25	HD64F3069RXBL25	

Appendix G Package Dimensions

Figures G.1 show the FP-100B package dimensions of the H8/3069R. Figure G.2 shows the TFP-100B package dimensions.

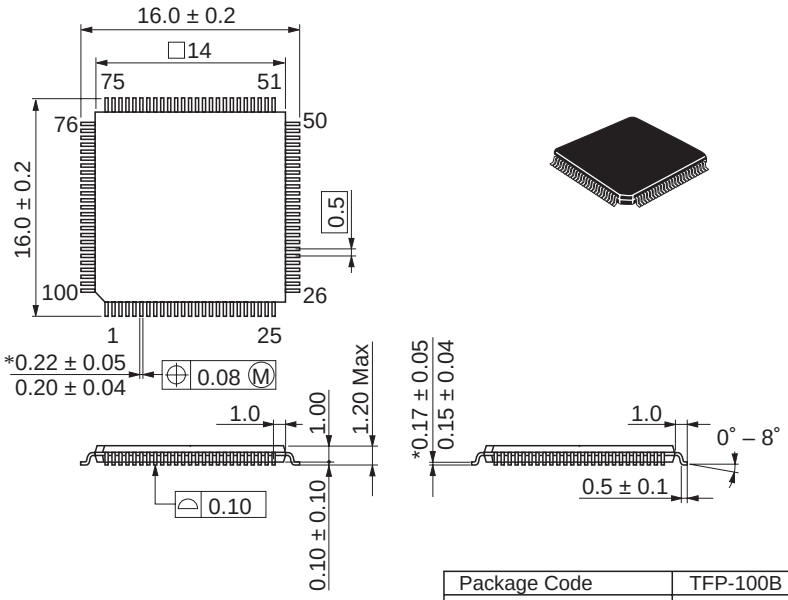


Package Code	FP-100B
JEDEC	—
JEITA	Conforms
Mass (reference value)	1.2 g

Figure G.1 Package Dimensions (FP-100B)

As of January, 2003

Unit: mm



Package Code	TFP-100B
JEDEC	—
JEITA	Conforms
Mass (reference value)	0.5 g

*Dimension including the plating thickness
Base material dimension

Figure G.2 Package Dimensions (TFP-100B)

Appendix H Comparison of H8/300H Series Product Specifications

H.1 Differences between H8/3069R and H8/3029, H8/3067 Group and H8/3062 Group, H8/3048 Group, H8/3007 and H8/3006, and H8/3002

	Item		H8/3069R, H8/3029	H8/3067 Group, H8/3062 Group	H8/3048 Group	H8/3007, H8/3006	H8/3002
1	Operating mode	Mode 5	16 Mbytes ROM enabled expanded mode	16 Mbytes ROM enabled expanded mode	1 Mbyte ROM enabled expanded mode		
		Mode 6	—	64 kbytes single-chip mode	16 Mbyte ROM enabled expanded mode		
2	Interrupt controller	Internal interrupt sources	36	36 (H8/3067) 27 (H8/3062)	30	36	30
3	Bus controller	Burst ROM interface	Yes	Yes (H8/3067) No (H8/3062)	No	Yes	No
		Idle cycle insertion function	Yes	Yes	No	Yes	No
		Wait mode	2 modes	2 modes	4 modes	2 modes	4 modes
		Wait state number setting	Per area	Per area	Common to all areas	Per area	Common to all areas
		Address output method	Choice of address update fixed	Choice of address update mode (fixed in H8/3067F-ZTAT and H8/3062F-ZTAT)	Fixed	Fixed	Fixed
4	DRAM interface	Connect-able areas	Area 2/3/4/5	Area 2/3/4/5 (H8/3067 only)	Area 3	Area 2/3/4/5	Area 3

	Item		H8/3069R, H8/3029		H8/3067 Group, H8/3062 Group		H8/3048 Group	H8/3007, H8/3006		H8/3002
4	DRAM interface	Precharge cycle insertion function	Yes		Yes (H8/3067 only)		No	Yes		No
		Fast page mode	Yes		Yes (H8/3067 only)		No	Yes		No
		Address shift amount	8 bit/9 bit/10 bit		8 bit/9 bit/10 bit (H8/3067 only)		8 bit/9 bit	8-bit/9-bit/10-bit		8-bit/9-bit
5	Timer functions		16-bit timers	8-bit timers	16-bit timers	8-bit timers	ITU	16-bit timers	8-bit timers	ITU
		Number of channels	16 bits × 3	8 bits × 4 (16 bits × 2)	16 bits × 3	8 bits × 4 (16 bits × 2)	16 bits × 5	16 bits x 3	8 bits x 4 (16 bits x 2)	16 bits x 5
		Pulse output	6 pins	4 pins (2 pins)	6 pins	4 pins (2 pins)	12 pins	6 pins	4 pins (2 pins)	12 pins
		Input capture	6	2	6	2	10	6	2	10
		External clock	4 systems (select-able)	4 systems (fixed)	4 systems (select-able)	4 systems (fixed)	4 systems (select-able)	4 systems (select-able)	4 systems (fixed)	4 systems (select-able)
		Internal clock	φ, φ/2, φ/4, φ/8	φ/8, φ/64, φ/8192	φ, φ/2, φ/4, φ/8	φ/8, φ/64, φ/8192	φ, φ/2, φ/4, φ/8	φ, φ/2, φ/4, φ/8	φ/8, φ/64, φ/8192	φ, φ/2, φ/4, φ/8
		Comple-mentary PWM function	No	No	No	No	Yes	No	No	Yes
		Reset-synchro-nous PWM function	No	No	No	No	Yes	No	No	Yes
		Buffer operation	No	No	No	No	Yes	No	No	Yes
		Output initializa-tion function	Yes	No	Yes	No	No	Yes	No	No

	Item		H8/3069R, H8/3029		H8/3067 Group, H8/3062 Group		H8/3048 Group	H8/3007, H8/3006		H8/3002
5	Timer functions	PWM output	3	4 (2)	3	4 (2)	5	3	4 (2)	5
		DMAC activation	3 channels	No	3 channels (H8/3067 only)	No	4 channels	3 channels	No	4 channels
		A/D conversion activation	No	Yes	No	Yes	No	No	Yes	No
		Interrupt sources	3 sources × 3	8 sources	3 sources × 3	8 sources	3 sources × 5	3 sources × 3	8 sources	3 sources × 5
6	TPC	Time base	3 kinds, 16-bit timer base		3 kinds, 16-bit timer base		4 kinds, ITU base	3 kinds, 16-bit timer base		4 kinds, ITU base
7	WDT	Reset signal external output function	No		Yes (except products with on-chip flash memory)		Yes	Yes	Yes	Yes
8	SCI	Number of channels	3 channels		3 channels (H8/3067) 2 channels (H8/3062)		2 channels	3 channels		2 channels
		Smart card interface	Supported on all channels		Supported on all channels		Supported on SCI0 only	Supported on all channels		No

	Item		H8/3069R, H8/3029	H8/3067 Group, H8/3062 Group	H8/3048 Group	H8/3007, H8/3006	H8/3002
9	A/D converter	Conversion start trigger input	External trigger/8-bit timer compare match	External trigger/8-bit timer compare match	External trigger	External trigger/8-bit timer compare match	External trigger
		Conversion state	70/134	70/134	134/266	70/134	134/266
10	Pin control	φ pin	φ/input port multiplexing	φ/input port multiplexing	φ output only	φ /input port multiplexing	φ output only
		A_{20} in 16 MB ROM enabled expanded mode	A_{20} / I/O port multiplexing	A_{20} / I/O port multiplexing	A_{20} output		
		Address bus, $\overline{AS}$, $\overline{RD}$, $\overline{HWR}$, $\overline{LWR}$, $\overline{CS_7}$–$\overline{CS_0}$, $\overline{RFSH}$ in software standby state	High-level output/high-impedance selectable	High-level output/high-impedance selectable ($\overline{RFSH}$: H8/3067 only)	High-level output (except $\overline{CS_0}$) Low-level output ($\overline{CS_0}$)	High-level output/high-impedance selectable	High-level output (except $\overline{CS_0}$) Low-level output ($\overline{CS_0}$)
		$\overline{CS_7}$–$\overline{CS_0}$ in bus-released state	High-impedance	High-impedance	High-level output	High-impedance	High-level output
11	Flash memory functions	Program/ erase voltage	12 V application unnecessary. Single-power-supply programming.	12 V application unnecessary. Single-power-supply programming.	12 V application from off-chip		
		Block divisions	16 blocks	8 blocks (12 blocks in H8/3064F-ZTAT)	16 blocks		
		Boot mode	Yes	Yes	Yes		
		User program mode	Yes	Yes	Yes		
		User boot mode	Yes	No	No		

H.2 Comparison of Pin Functions of 100-Pin Package Products (FP-100B, TFP-100B)

Table H.1 Pin Arrangement of Each Product (FP-100B, TFP-100B)

						ROMless Version	
Pin No.	H8/3069R, H8/3029	H8/3067 Group	H8/3062 Group	H8/3048 Group	H8/3042 Group	H8/3007, H8/3006	H8/3002
1	VCL	VCC	VCC/VCL*[2]	VCC	VCC	VCC	VCC
2	$PB_0/TP_8/TMO_0/\overline{CS_7}$	$PB_0/TP_8/TMO_0/\overline{CS_7}$	$PB_0/TP_8/TMO_0/\overline{CS_7}$	$PB_0/TP_8/TIOCA_3$	$PB_0/TP_8/TIOCA_3$	$PB_0/TP_8/TMO_0/\overline{CS_7}$	PB_0/TP_8/TIOCA3
3	$PB_1/TP_9/TMIO_1/DREQ_0/\overline{CS_6}$	$PB_1/TP_9/TMIO_1/DREQ_0/\overline{CS_6}$	$PB_1/TP_9/TMIO_1/\overline{CS_6}$	$PB_1/TP_9/TIOCB_3$	$PB_1/TP_9/TIOCB_3$	$PB_1/TP_9/TMIO_1/DREQ_0/\overline{CS_6}$	PB_1/TP_9/TIOCB3
4	$PB_2/TP_{10}/TMO_2/\overline{CS_5}$	$PB_2/TP_{10}/TMO_2/\overline{CS_5}$	$PB_2/TP_{10}/TMO_2/\overline{CS_5}$	$PB_2/TP_{10}/TIOCA_4$	$PB_2/TP_{10}/TIOCA_4$	$PB_2/TP_{10}/TMO_2/\overline{CS_5}$	PB_2/TP_{10}/TIOCA4
5	$PB_3/TP_{11}/TMIO_3/DREQ_1/\overline{CS_4}$	$PB_3/TP_{11}/TMIO_3/DREQ_1/\overline{CS_4}$	$PB_3/TP_{11}/TMIO_3/\overline{CS_4}$	$PB_3/TP_{11}/TIOCB_4$	$PB_3/TP_{11}/TIOCB_4$	$PB_3/TP_{11}/TMIO_3/DREQ_1/\overline{CS_4}$	PB_3/TP_{11}/TIOCB4
6	$PB_4/TP_{12}/\overline{UCAS}$	$PB_4/TP_{12}/\overline{UCAS}$	PB_4/TP_{12}	$PB_4/TP_{12}/TOCXA_4$	$PB_4/TP_{12}/TOCXA_4$	$PB_4/TP_{12}/\overline{UCAS}$	$PB_4/TP_{12}/TOCXA_4$
7	$PB_5/TP_{13}/\overline{LCAS}/SCK_2$	$PB_5/TP_{13}/\overline{LCAS}/SCK_2$	PB_5/TP_{13}	$PB_5/TP_{13}/TOCXB_4$	$PB_5/TP_{13}/TOCXB_4$	$PB_5/TP_{13}/\overline{LCAS}/SCK_2$	$PB_5/TP_{13}/TOCXB_4$
8	$PB_6/TP_{14}/TxD_2$	$PB_6/TP_{14}/TxD_2$	PB_6/TP_{14}	$PB_6/TP_{14}/\overline{DREQ_0}/\overline{CS_7}$	$PB_6/TP_{14}/\overline{DREQ_0}$	$PB_6/TP_{14}/TxD_2$	$PB_6/TP_{14}/\overline{DREQ_0}$
9	$PB_7/TP_{15}/RxD_2$	$PB_7/TP_{15}/RxD_2$	PB_7/TP_{15}	$PB_7/TP_{15}/\overline{DREQ_1}/\overline{ADTRG}$	$PB_7/TP_{15}/\overline{DREQ_1}/\overline{ADTRG}$	$PB_7/TP_{15}/RxD_2$	$PB_7/TP_{16}/\overline{DREQ_1}/\overline{ADTRG}$
10	FWE	$\overline{RESO}$/FWE*[1]	$\overline{RESO}$/FWE*[1]	$\overline{RESO}/V_{PP}$	$\overline{RESO}$	$\overline{RESO}$	$\overline{RESO}$
11	Vss	Vss	Vss	Vss	Vss	Vss	Vss
12	$P9_0/TxD_0$	$P9_0/TxD_0$	$P9_0/TxD_0$	$P9_0/TxD_0$	$P9_0/TxD_0$	$P9_0/TxD_0$	$P9_0/TxD_0$
13	$P9_1/TxD_1$	$P9_1/TxD_1$	$P9_1/TxD_1$	$P9_1/TxD_1$	$P9_1/TxD_1$	$P9_1/TxD_1$	$P9_1/TxD_1$
14	$P9_2/RxD_0$	$P9_2/RxD_0$	$P9_2/RxD_0$	$P9_2/RxD_0$	$P9_2/RxD_0$	$P9_2/RxD_0$	$P9_2/RxD_0$
15	$P9_3/RxD_1$	$P9_3/RxD_1$	$P9_3/RxD_1$	$P9_3/RxD_1$	$P9_3/RxD_1$	$P9_3/RxD_1$	$P9_3/RxD_1$
16	$P9_4/SCK_0/\overline{IRQ_4}$	$P9_4/SCK_0/\overline{IRQ_4}$	$P9_4/SCK_0/\overline{IRQ_4}$	$P9_4/SCK_0/\overline{IRQ_4}$	$P9_4/SCK_0/\overline{IRQ_4}$	$P9_4/SCK_0/\overline{IRQ_4}$	$P9_4/SCK_0/\overline{IRQ_4}$
17	$P9_5/SCK_1/\overline{IRQ_5}$	$P9_5/SCK_1/\overline{IRQ_5}$	$P9_5/SCK_1/\overline{IRQ_5}$	$P9_5/SCK_1/\overline{IRQ_5}$	$P9_5/SCK_1/\overline{IRQ_5}$	$P9_5/SCK_1/\overline{IRQ_5}$	$P9_5/SCK_1/\overline{IRQ_5}$
18	$P4_0/D_0$	$P4_0/D_0$	$P4_0/D_0$	$P4_0/D_0$	$P4_0/D_0$	$P4_0/D_0$	$P4_0/D_0$
19	$P4_1/D_1$	$P4_1/D_1$	$P4_1/D_1$	$P4_1/D_1$	$P4_1/D_1$	$P4_1/D_1$	$P4_1/D_1$

						ROMless Version	
Pin No.	H8/3069R, H8/3029	H8/3067 Group	H8/3062 Group	H8/3048 Group	H8/3042 Group	H8/3007, H8/3006	H8/3002
20	$P4_2/D_2$	$P4_2/D_2$	$P4_2/D_2$	$P4_2/D_2$	$P4_2/D_2$	$P4_2/D_2$	$P4_2/D_2$
21	$P4_3/D_3$	$P4_3/D_3$	$P4_3/D_3$	$P4_3/D_3$	$P4_3/D_3$	$P4_3/D_3$	$P4_3/D_3$
22	Vss	Vss	Vss	Vss	Vss	Vss	Vss
23	$P4_4/D_4$	$P4_4/D_4$	$P4_4/D_4$	$P4_4/D_4$	$P4_4/D_4$	$P4_4/D_4$	$P4_4/D_4$
24	$P4_5/D_5$	$P4_5/D_5$	$P4_5/D_5$	$P4_5/D_5$	$P4_5/D_5$	$P4_5/D_5$	$P4_5/D_5$
25	$P4_6/D_6$	$P4_6/D_6$	$P4_6/D_6$	$P4_6/D_6$	$P4_6/D_6$	$P4_6/D_6$	$P4_6/D_6$
26	$P4_7/D_7$	$P4_7/D_7$	$P4_7/D_7$	$P4_7/D_7$	$P4_7/D_7$	$P4_7/D_7$	$P4_7/D_7$
27	$P3_0/D_8$	$P3_0/D_8$	$P3_0/D_8$	$P3_0/D_8$	$P3_0/D_8$	D_8	D_8
28	$P3_1/D_9$	$P3_1/D_9$	$P3_1/D_9$	$P3_1/D_9$	$P3_1/D_9$	D_9	D_9
29	$P3_2/D_{10}$	$P3_2/D_{10}$	$P3_2/D_{10}$	$P3_2/D_{10}$	$P3_2/D_{10}$	D_{10}	D_{10}
30	$P3_3/D_{11}$	$P3_3/D_{11}$	$P3_3/D_{11}$	$P3_3/D_{11}$	$P3_3/D_{11}$	D_{11}	D_{11}
31	$P3_4/D_{12}$	$P3_4/D_{12}$	$P3_4/D_{12}$	$P3_4/D_{12}$	$P3_4/D_{12}$	D_{12}	D_{12}
32	$P3_5/D_{13}$	$P3_5/D_{13}$	$P3_5/D_{13}$	$P3_5/D_{13}$	$P3_5/D_{13}$	D_{13}	D_{13}
33	$P3_6/D_{14}$	$P3_6/D_{14}$	$P3_6/D_{14}$	$P3_6/D_{14}$	$P3_6/D_{14}$	D_{14}	D_{14}
34	$P3_7/D_{15}$	$P3_7/D_{15}$	$P3_7/D_{15}$	$P3_7/D_{15}$	$P3_7/D_{15}$	D_{15}	D_{15}
35	Vcc	Vcc	Vcc	Vcc	Vcc	Vcc	Vcc
36	$P1_0/A_0$	$P1_0/A_0$	$P1_0/A_0$	$P1_0/A_0$	$P1_0/A_0$	A_0	A_0
37	$P1_1/A_1$	$P1_1/A_1$	$P1_1/A_1$	$P1_1/A_1$	$P1_1/A_1$	A_1	A_1
38	$P1_2/A_2$	$P1_2/A_2$	$P1_2/A_2$	$P1_2/A_2$	$P1_2/A_2$	A_2	A_2
39	$P1_3/A_3$	$P1_3/A_3$	$P1_3/A_3$	$P1_3/A_3$	$P1_3/A_3$	A_3	A_3
40	$P1_4/A_4$	$P1_4/A_4$	$P1_4/A_4$	$P1_4/A_4$	$P1_4/A_4$	A_4	A_4
41	$P1_5/A_5$	$P1_5/A_5$	$P1_5/A_5$	$P1_5/A_5$	$P1_5/A_5$	A_5	A_5
42	$P1_6/A_6$	$P1_6/A_6$	$P1_6/A_6$	$P1_6/A_6$	$P1_6/A_6$	A_6	A_6
43	$P1_7/A_7$	$P1_7/A_7$	$P1_7/A_7$	$P1_7/A_7$	$P1_7/A_7$	A_7	A_7
44	Vss	Vss	Vss	Vss	Vss	Vss	Vss
45	$P2_0/A_8$	$P2_0/A_8$	$P2_0/A_8$	$P2_0/A_8$	$P2_0/A_8$	A_8	A_8
46	$P2_1/A_9$	$P2_1/A_9$	$P2_1/A_9$	$P2_1/A_9$	$P2_1/A_9$	A_9	A_9
47	$P2_2/A_{10}$	$P2_2/A_{10}$	$P2_2/A_{10}$	$P2_2/A_{10}$	$P2_2/A_{10}$	A_{10}	A_{10}
48	$P2_3/A_{11}$	$P2_3/A_{11}$	$P2_3/A_{11}$	$P2_3/A_{11}$	$P2_3/A_{11}$	A_{11}	A_{11}
49	$P2_4/A_{12}$	$P2_4/A_{12}$	$P2_4/A_{12}$	$P2_4/A_{12}$	$P2_4/A_{12}$	A_{12}	A_{12}
50	$P2_5/A_{13}$	$P2_5/A_{13}$	$P2_5/A_{13}$	$P2_5/A_{13}$	$P2_5/A_{13}$	A_{13}	A_{13}
51	$P2_6/A_{14}$	$P2_6/A_{14}$	$P2_6/A_{14}$	$P2_6/A_{14}$	$P2_6/A_{14}$	A_{14}	A_{14}
52	$P2_7/A_{15}$	$P2_7/A_{15}$	$P2_7/A_{15}$	$P2_7/A_{15}$	$P2_7/A_{15}$	A_{15}	A_{15}
53	$P5_0/A_{16}$	$P5_0/A_{16}$	$P5_0/A_{16}$	$P5_0/A_{16}$	$P5_0/A_{16}$	A_{16}	A_{16}
54	$P5_1/A_{17}$	$P5_1/A_{17}$	$P5_1/A_{17}$	$P5_1/A_{17}$	$P5_1/A_{17}$	A_{17}	A_{17}
55	$P5_2/A_{18}$	$P5_2/A_{18}$	$P5_2/A_{18}$	$P5_2/A_{18}$	$P5_2/A_{18}$	A_{18}	A_{18}
56	$P5_3/A_{19}$	$P5_3/A_{19}$	$P5_3/A_{19}$	$P5_3/A_{19}$	$P5_3/A_{19}$	A_{19}	A_{19}

						ROMless Version	
Pin No.	H8/3069R, H8/3029	H8/3067 Group	H8/3062 Group	H8/3048 Group	H8/3042 Group	H8/3007, H8/3006	H8/3002
57	Vss	Vss	Vss	Vss	Vss	Vss	Vss
58	$P6_0/\overline{WAIT}$	$P6_0/\overline{WAIT}$	$P6_0/\overline{WAIT}$	$P6_0/\overline{WAIT}$	$P6_0/\overline{WAIT}$	$P6_0/\overline{WAIT}$	$P6_0/\overline{WAIT}$
59	$P6_1/\overline{BREQ}$	$P6_1/\overline{BREQ}$	$P6_1/\overline{BREQ}$	$P6_1/\overline{BREQ}$	$P6_1/\overline{BREQ}$	$P6_1/\overline{BREQ}$	$P6_1/\overline{BREQ}$
60	$P6_2/\overline{BACK}$	$P6_2/\overline{BACK}$	$P6_2/\overline{BACK}$	$P6_2/\overline{BACK}$	$P6_2/\overline{BACK}$	$P6_2/\overline{BACK}$	$P6_2/\overline{BACK}$
61	$P6_7/\phi$	$P6_7/\phi$	$P6_7/\phi$	ϕ	ϕ	$P6_7/\phi$	ϕ
62	$\overline{STBY}$	$\overline{STBY}$	$\overline{STBY}$	$\overline{STBY}$	$\overline{STBY}$	$\overline{STBY}$	$\overline{STBY}$
63	$\overline{RES}$	$\overline{RES}$	$\overline{RES}$	$\overline{RES}$	$\overline{RES}$	$\overline{RES}$	$\overline{RES}$
64	NMI	NMI	NMI	NMI	NMI	NMI	NMI
65	Vss	Vss	Vss	Vss	Vss	Vss	NMI
66	EXTAL	EXTAL	EXTAL	EXTAL	EXTAL	EXTAL	EXTAL
67	XTAL	XTAL	XTAL	XTAL	XTAL	XTAL	XTAL
68	Vcc	Vcc	Vcc	Vcc	Vcc	Vcc	Vcc
69	$P6_3/\overline{AS}$	$P6_3/\overline{AS}$	$P6_3/\overline{AS}$	$P6_3/\overline{AS}$	$P6_3/\overline{AS}$	$\overline{AS}$	$\overline{AS}$
70	$P6_4/\overline{RD}$	$P6_4/\overline{RD}$	$P6_4/\overline{RD}$	$P6_4/\overline{RD}$	$P6_4/\overline{RD}$	$\overline{RD}$	$\overline{RD}$
71	$P6_5/\overline{HWR}$	$P6_5/\overline{HWR}$	$P6_5/\overline{HWR}$	$P6_5/\overline{HWR}$	$P6_5/\overline{HWR}$	$\overline{HWR}$	$\overline{HWR}$
72	$P6_6/\overline{LWR}$	$P6_6/\overline{LWR}$	$P6_6/\overline{LWR}$	$P6_6/\overline{LWR}$	$P6_6/\overline{LWR}$	$\overline{LWR}$	$\overline{LWR}$
73	MD_0	MD_0	MD_0	MD_0	MD_0	MD_0	MD_0
74	MD_1	MD_1	MD_1	MD_1	MD_1	MD_1	MD_1
75	MD_2	MD_2	MD_2	MD_2	MD_2	MD_2	MD_2
76	AVcc	AVcc	AVcc	AVcc	AVcc	AVcc	AVcc
77	V_{REF}	V_{REF}	V_{REF}	V_{REF}	V_{REF}	V_{REF}	V_{REF}
78	$P7_0/AN_0$	$P7_0/AN_0$	$P7_0/AN_0$	$P7_0/AN_0$	$P7_0/AN_0$	$P7_0/AN_0$	$P7_0/AN_0$
79	$P7_1/AN_1$	$P7_1/AN_1$	$P7_1/AN_1$	$P7_1/AN_1$	$P7_1/AN_1$	$P7_1/AN_1$	$P7_1/AN_1$
80	$P7_2/AN_2$	$P7_2/AN_2$	$P7_2/AN_2$	$P7_2/AN_2$	$P7_2/AN_2$	$P7_2/AN_2$	$P7_2/AN_2$
81	$P7_3/AN_3$	$P7_3/AN_3$	$P7_3/AN_3$	$P7_3/AN_3$	$P7_3/AN_3$	$P7_3/AN_3$	$P7_3/AN_3$
82	$P7_4/AN_4$	$P7_4/AN_4$	$P7_4/AN_4$	$P7_4/AN_4$	$P7_4/AN_4$	$P7_4/AN_4$	$P7_4/AN_4$
83	$P7_5/AN_5$	$P7_5/AN_5$	$P7_5/AN_5$	$P7_5/AN_5$	$P7_5/AN_5$	$P7_5/AN_5$	$P7_5/AN_5$
84	$P7_6/AN_6/DA_0$	$P7_6/AN_6/DA_0$	$P7_6/AN_6/DA_0$	$P7_6/AN_6/DA_0$	$P7_6/AN_6/DA_0$	$P7_6/AN_6/DA_0$	$P7_6/AN_6$
85	$P7_7/AN_7/DA_1$	$P7_7/AN_7/DA_1$	$P7_7/AN_7/DA_1$	$P7_7/AN_7/DA_1$	$P7_7/AN_7/DA_1$	$P7_7/AN_7$	$P7_7/AN_7$
86	AVss	AVss	AVss	AVss	AVss	AVss	AVss
87	$P8_0/\overline{RFSH}/\overline{IRQ_0}$	$P8_0/\overline{RFSH}/\overline{IRQ_0}$	$P8_0/\overline{IRQ_0}$	$P8_0/\overline{RFSH}/\overline{IRQ_0}$	$P8_0/\overline{RFSH}/\overline{IRQ_0}$	$P8_0/\overline{RFSH}/\overline{IRQ_0}$	$P8_0/\overline{RFSH}/\overline{IRQ_0}$
88	$P8_1/\overline{CS_3}/\overline{IRQ_1}$	$P8_1/\overline{CS_3}/\overline{IRQ_1}$	$P8_1/\overline{CS_3}/\overline{IRQ_1}$	$P8_1/\overline{CS_3}/\overline{IRQ_1}$	$P8_1/\overline{CS_3}/\overline{IRQ_1}$	$P8_1/\overline{CS_3}/\overline{IRQ_1}$	$P8_1/\overline{CS_3}/\overline{IRQ_1}$
89	$P8_2/\overline{CS_2}/\overline{IRQ_2}$	$P8_2/\overline{CS_2}/\overline{IRQ_2}$	$P8_2/\overline{CS_2}/\overline{IRQ_2}$	$P8_2/\overline{CS_2}/\overline{IRQ_2}$	$P8_2/\overline{CS_2}/\overline{IRQ_2}$	$P8_2/\overline{CS_2}/\overline{IRQ_2}$	$P8_2/\overline{CS_2}/\overline{IRQ_2}$
90	$P8_3/\overline{CS_1}/\overline{IRQ_3}/\overline{ADTRG}$	$P8_3/\overline{CS_1}/\overline{IRQ_3}/\overline{ADTRG}$	$P8_3/\overline{CS_1}/\overline{IRQ_3}/\overline{ADTRG}$	$P8_3/\overline{CS_1}/\overline{IRQ_3}$	$P8_3/\overline{CS_1}/\overline{IRQ_3}$	$P8_3/\overline{CS_1}/\overline{IRQ_3}/\overline{ADTRG}$	$P8_3/\overline{CS_1}/\overline{IRQ_3}$
91	$P8_4/\overline{CS_0}$	$P8_4/\overline{CS_0}$	$P8_4/\overline{CS_0}$	$P8_4/\overline{CS_0}$	$P8_4/\overline{CS_0}$	$P8_4/\overline{CS_0}$	$P8_4/\overline{CS_0}$

Pin No.	H8/3069R, H8/3029	H8/3067 Group	H8/3062 Group	H8/3048 Group	H8/3042 Group	ROMless Version H8/3007, H8/3006	ROMless Version H8/3002
92	Vss	Vss	Vss	Vss	Vss	Vss	Vss
93	$PA_0/TP_0/\overline{TEND_0}/TCLKA$	$PA_0/TP_0/\overline{TEND_0}/TCLKA$	$PA_0/TP_0/TCLKA$	$PA_0/TP_0/\overline{TEND_0}/TCLKA$	$PA_0/TP_0/\overline{TEND_0}/TCLKA$	$PA_0/TP_0/\overline{TEND_0}/TCLKA$	$PA_0/TP_0/\overline{TEND_0}/TCLKA$
94	$PA_1/TP_1/\overline{TEND_1}/TCLKB$	$PA_1/TP_1/\overline{TEND_1}/TCLKB$	$PA_1/TP_1/TCLKB$	$PA_1/TP_1/\overline{TEND_1}/TCLKB$	$PA_1/TP_1/\overline{TEND_1}/TCLKB$	$PA_1/TP_1/\overline{TEND_1}/TCLKB$	$PA_1/TP_1/\overline{TEND_1}/TCLKB$
95	$PA_2/TP_2/TIOCA_0/TCLKC$	$PA_2/TP_2/TIOCA_0/TCLKC$	$PA_2/TP_2/TIOCA_0/TCLKC$	$PA_2/TP_2/TIOCA_0/TCLKC$	$PA_2/TP_2/TIOCA_0/TCLKC$	$PA_2/TP_2/TIOCA_0/TCLKC$	$PA_2/TP_2/TIOCA_0/TCLKC$
96	$PA_3/TP_3/TIOCB_0/TCLKD$	$PA_3/TP_3/TIOCB_0/TCLKD$	$PA_3/TP_3/TIOCB_0/TCLKD$	$PA_3/TP_3/TIOCB_0/TCLKD$	$PA_3/TP_3/TIOCB_0/TCLKD$	$PA_3/TP_3/TIOCB_0/TCLKD$	$PA_3/TP_3/TIOCB_0/TCLKD$
97	$PA_4/TP_4/TIOCA_1/A_{23}$	$PA_4/TP_4/TIOCA_1/A_{23}$	$PA_4/TP_4/TIOCA_1/A_{23}$	$PA_4/TP_4/TIOCA_1/\overline{CS_6}/A_{23}$	$PA_4/TP_4/TIOCA_1/A_{23}$	$PA_4/TP_4/TIOCA_1/A_{23}$	$PA_4/TP_4/TIOCA_1/A_{23}$
98	$PA_5/TP_5/TIOCB_1/A_{22}$	$PA_5/TP_5/TIOCB_1/A_{22}$	$PA_5/TP_5/TIOCB_1/A_{22}$	$PA_5/TP_5/TIOCB_1/\overline{CS_5}/A_{22}$	$PA_5/TP_5/TIOCB_1/A_{22}$	$PA_5/TP_5/TIOCB_1/A_{22}$	$PA_5/TP_5/TIOCB_1/A_{22}$
99	$PA_6/TP_6/TIOCA_2/A_{21}$	$PA_6/TP_6/TIOCA_2/A_{21}$	$PA_6/TP_6/TIOCA_2/A_{21}$	$PA_6/TP_6/TIOCA_2/\overline{CS_4}/A_{21}$	$PA_6/TP_6/TIOCA_2/A_{21}$	$PA_6/TP_6/TIOCA_2/A_{21}$	$PA_6/TP_6/TIOCA_2/A_{21}$
100	$PA_7/TP_7/TIOCB_2/A_{20}$	$PA_7/TP_7/TIOCB_2/A_{20}$	$PA_7/TP_7/TIOCB_2/A_{20}$	$PA_7/TP_7/TIOCB_2/A_{20}$	$PA_7/TP_7/TIOCB_2/A_{20}$	$PA_7/TP_7/TIOCB_2/A_{20}$	$PA_7/TP_7/TIOCB_2/A_{20}$

Notes: 1. Functions as $\overline{RESO}$ in the mask ROM versions, and as FWE in the flash memory and flash memory R versions.

2. Functions as the V_{CL} pin in the 5-V products of the H8/3064F-ZTAT and H8/3062F-ZTAT B-mask versions, and requires an external capacitor (0.1 μF).

Renesas 16-Bit Single-Chip Microcomputer
Hardware Manual
H8/3069RF-ZTAT™

Publication Date:	1st Edition, March, 2002
	Rev.5.00, September 10, 2004
Published by:	Sales Strategic Planning Div.
	Renesas Technology Corp.
Edited by:	Technical Documentation & Information Department
	Renesas Kodaira Semiconductor Co., Ltd.

© 2004. Renesas Technology Corp., All rights reserved. Printed in Japan.

Renesas Technology Corp. Sales Strategic Planning Div. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan

RENESAS SALES OFFICES

http://www.renesas.com

Refer to "**http://www.renesas.com/en/network**" for the latest and detailed information.

Renesas Technology America, Inc.
450 Holger Way, San Jose, CA 95134-1368, U.S.A
Tel: <1> (408) 382-7500, Fax: <1> (408) 382-7501

Renesas Technology Europe Limited
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K.
Tel: <44> (1628) 585-100, Fax: <44> (1628) 585-900

Renesas Technology Hong Kong Ltd.
7th Floor, North Tower, World Finance Centre, Harbour City, 1 Canton Road, Tsimshatsui, Kowloon, Hong Kong
Tel: <852> 2265-6688, Fax: <852> 2730-6071

Renesas Technology Taiwan Co., Ltd.
10th Floor, No.99, Fushing North Road, Taipei, Taiwan
Tel: <886> (2) 2715-2888, Fax: <886> (2) 2713-2999

Renesas Technology (Shanghai) Co., Ltd.
Unit2607 Ruijing Building, No.205 Maoming Road (S), Shanghai 200020, China
Tel: <86> (21) 6472-1001, Fax: <86> (21) 6415-2952

Renesas Technology Singapore Pte. Ltd.
1 Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632
Tel: <65> 6213-0200, Fax: <65> 6278-8001

H8/3069RF-ZTAT™
Hardware Manual

Renesas Technology Corp.
2-6-2, Ote-machi, Chiyoda-ku, Tokyo, 100-0004, Japan